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 **HITACHI**

8/16-BIT MULTI-CHIP MICROCOMPUTER
DATA BOOK

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8/16-BIT MULTI-CHIP MICROCOMPUTER DATABOOK



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GENERAL INFORMATION

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QUICK REFERENCE GUIDE

■ 8-BIT MULTI-CHIP MICROCOMPUTERS

Division	Type No.		LSI Characteristics				Function	Compatibility	Reference Page	
	Old Type No.	Process	Clock Frequency (MHz)	Supply Voltage (V)	Operating** Temperature (°C)	Package†				
MPU	HD6803			1.0	5.0	0 ~ +70	DP-40	Microprocessor +128 Bytes of RAM	MC6803	33
	HD6803-1			1.25					MC6803-1	33
	HD6303R			1.0	5.0	0 ~ +70	DP-40 FP-54 CG-40	Microprocessor +128 Bytes of RAM		87
	HD63A03R			1.5						87
	HD63B03R			2.0						87
	HD6303X*			1.0	5.0	0 ~ +70	DP-64S FP-80	Microprocessor +192 Bytes of RAM		117
	HD63A03X*			1.5						117
	HD63B03X*			2.0						117
	HD6303Y**			1.0	5.0	0 ~ +70	DP-64S FP-64	Microprocessor +256 Bytes of RAM		152
	HD63A03Y**			1.5						152
	HD63B03Y**			2.0						152
	HD6305X2*			1.0	5.0	0 ~ +70	DP-64S FP-64	Microprocessor +128 Bytes of RAM		155
	HD63A05X2*			1.5						155
	HD63B05X2*			2.0						155
	HD6305Y2*			1.0	5.0	0 ~ +70	DP-64S FP-64	Microprocessor +256 Bytes of RAM		188
	HD63A05Y2*			1.5						188
	HD63B05Y2*			2.0						188
	HD6800	HD46800D		1.0	5.0	-20 ~ +75	DP-40	Microprocessor	MC6800	221
	HD68A00	HD468A00		1.5					MC68A00	221
	HD68B00	HD468B00		2.0					MC68B00	221
	HD6802	HD46802		1.0	5.0	-20 ~ +75	DP-40	Microprocessor+Clock+128 Bytes of RAM	MC6802	253
	HD6802W			1.0	5.0	-20 ~ +75	DP-40	Microprocessor+Clock+256 Bytes of RAM		266
	HD6809			1.0	5.0	-20 ~ +75	DP-40	High-End 8-Bit Microprocessor	MC6809	279
	HD68A09			1.5					MC68A09	279
	HD68B09			2.0					MC68B09	279
				2.0						310
	HD6309**			2.5	5.0	-20 ~ +75	DP-40	High-End 8-Bit Microprocessor		310
				3.0						310
			2.0							
HD6809E			1.0	5.0	-20 ~ +75	DP-40	High-End 8-Bit Microprocessor (External Clock Type)	MC6809E	311	
HD68A09E			1.5					MC68A09E	311	
HD68B09E			2.0					MC68B09E	311	
			2.0						344	
HD6309E**			2.5	5.0	-20 ~ +75	DP-40	High-End 8-Bit Microprocessor (External Clock Type)		344	
			3.0						344	
			2.0							
PIA	HD6821	HD46821		1.0	5.0	-20 ~ +75	DP-40	Peripheral Interface Adapter	MC6821	345
	HD68A21	HD468A21		1.5					MC68A21	345
	HD68B21	HD468B21		2.0					MC68B21	345
	HD6321*			1.0	5.0	-20 ~ +75	DP-40 FP-54	Peripheral Interface Adapter		362
	HD63A21*			1.5						362
	HD63B21*			2.0						362
PTM	HD6840			1.0	5.0	-20 ~ +75	DP-28	Programmable Timer Module	MC6840	381
	HD68A40			1.5					MC68A40	381
	HD68B40			2.0					MC68B40	381
	HD6340*			1.0	5.0	-20 ~ +75	DP-28	Programmable Timer Module		395
	HD63A40*			1.5						395
HD63B40*			2.0						395	
FDC	HD6843	HD46803S		1.0	5.0	0 ~ +75	DP-40	Floppy Disk Controller	MC6843	410
	HD68A43	HD46803S-1		1.5						410
DMAC	HD6844	HD46804		1.0	5.0	-20 ~ +75	DP-40	Direct Memory Access Controller	MC6844	437
	HD68A44	HD46804-1		1.5					MC68A44	437
	HD68B44	HD46804-2		2.0					MC68B44	437
	HD6845	HD46805R		1.0						
CRTC	HD68A45	HD46805R-1		1.5	5.0	-20 ~ +75	DP-40	CRT Controller (3.0MHz High-speed Display)	MC6845	509
	HD68B45	HD46805R-2		2.0					MC68A45	509
									MC68B45	509
	HD6845S	HD46805S		1.0	5.0	-20 ~ +75	DP-40	CRT Controller (3.7MHz High-speed Display)		470
	HD68A45S	HD46805S-1		1.5						470
	HD68B45S	HD46805S-2		2.0						470
COMBO	HD6846	HD46846		1.0	5.0	-20 ~ +75	DP-40	Combination ROM I/O Timer	MC6846	511
	HD6850	HD46850		1.0						
ACIA	HD68A50	HD468A50		1.5	5.0	-20 ~ +75	DP-24	Asynchronous Communications Interface Adapter	MC6850	532
	HD6350			1.0						532
	HD63A50			1.5						543
	HD63B50			2.0						543
SSDA	HD6852	HD46852		1.0	5.0	-20 ~ +75	DP-24	Synchronous Serial Data Adapter	MC6852	554
	HD68A52	HD468A52		1.5					MC68A52	554
	HD46808			1.0						568
ADU	HD46808-1			1.5	5.0	-20 ~ +75	DP-40	Analog Data Acquisition Unit		568
	HD46808A			1.0						568
	HD46808A-1			1.5						568
RTC	HD146818			1.0	5.0	0 ~ +70	DP-24 FP-24	Real Time Clock Plus RAM	MC146818	588
	HD6318**			1.0						607
	HD63A18**			1.5						607

* Preliminary ** Under development *** Wide Temperature Range (-40 ~ +85°C) version is available.

† DP: Plastic DIP, FP: Plastic Flat Package, CG: Glass-sealed Ceramic Leadless Chip Carrier

■ 16-BIT MULTI-CHIP MICROCOMPUTERS

Division	Type No.	LSI Characteristics					Function	Compatibility	Reference Page	
		Process	Clock Frequency (MHz)	Supply Voltage (V)	Operating Temperature (°C)	Package †				
MPU	HD68000-4	NMOS	4	5.0	0 ~ +70	DC-64	Microprocessor	MC68000L4	611	
	HD68000-6		6					MC68000L6	611	
	HD68000-8		8					MC68000L8	611	
	HD68000-10		10					MC68000L10	611	
	HD68000-12		12.5					MC68000L12	611	
	HD68000Y4		4					PGA-68	MC68000R4	611
	HD68000Y6		6			MC68000R6			611	
	HD68000Y8		8			MC68000R8			611	
	HD68000Y10		10			MC68000R10			611	
	HD68000Y12		12.5			MC68000R12			611	
	HD68000Z4		4			CG-68*			MC68000Z4	611
	HD68000Z6		6					MC68000Z6	611	
	HD68000Z8		8					MC68000Z8	611	
	HD68000Z10		10					MC68000Z10	611	
HD68000Z12	12.5	MC68000Z12	611							
Peripheral LSI	DMAC	NMOS	4	5.0	0 ~ +70		DC-64	Direct Memory Access Controller	MC68450L4	690
			HD68450-6			6			MC68450L6	690
			HD68450-8			8			MC68450L8	690
			HD68450-10*			10			MC68450L10	690
			HD68450-12**			12.5			—	690
			HD68450Y4			4	PGA-68*		—	690
			HD68450Y6			6			—	690
			HD68450Y8			8			—	690
			HD68450Y10*			10			—	690
			HD68450Y12**			12.5			—	690
	HDC	CMOS	4	5.0	-20 ~ +75	DC-48	Hard Disk Controller	—	737	
			HD63463-6**					6	—	737
			HD63463-8**					8	—	737
	ACRTC	CMOS	4	5.0	-20 ~ +75	DC-64	Advanced CRT Controller	—	738	
			HD63484-6**					6	—	738
			HD63484-8**					8	—	738

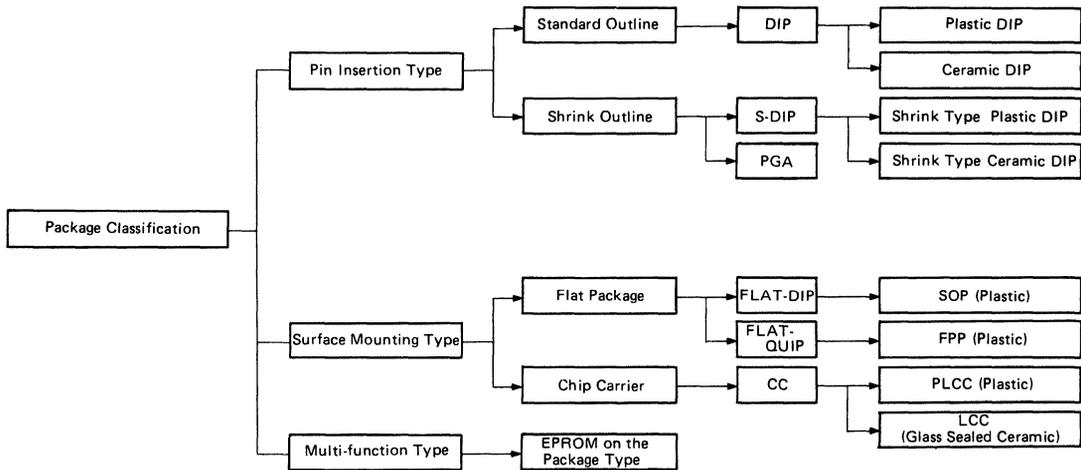
* Preliminary ** Under development † DC; Ceramic DIP, PGA; Pin Grid Array, CG; Glass-sealed Ceramic Leadless Chip Carrier

INTRODUCTION OF PACKAGES

Hitachi microcomputer devices are offered in a variety of packages, to meet various user requirements.

1. Package Classification

When selecting suitable packaging, please refer to the Package Classifications given in Fig. 1 for pin insertion, surface mount, and multi-function types, in plastic and ceramic.



DIP; DUAL IN LINE PACKAGE
 S-DIP; SHRINK DUAL IN LINE PACKAGE
 PGA; PIN GRID ARRAY
 FLAT-DIP; FLAT DUAL IN LINE PACKAGE
 FLAT-QUIP; FLAT QUAD IN LINE PACKAGE
 CC; CHIP CARRIER
 SOP; SMALL OUTLINE PACKAGE
 FPP; FLAT PLASTIC PACKAGE
 PLCC; PLASTIC LEADED CHIP CARRIER
 LCC; LEADLESS CHIP CARRIER

Fig. 1 Package Classification according to Material and Printed Circuit Board Mounting Type

2. Type No. and Package Code Indication

The Hitachi Type No. for multi-chip microcomputer devices is followed by package material and outline specifications, as shown below. The package type used for each device is identified

by code as follows, and illustrated in the data sheet for each device.

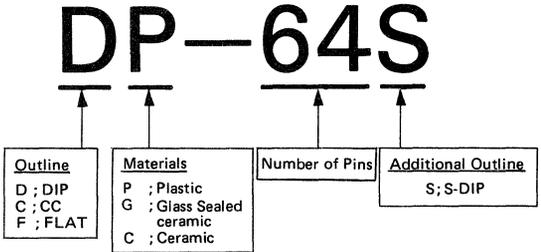
When ordering, please write the package code next to the type number.

Type No. Indication

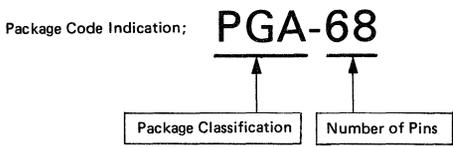
HD × × × × P

Package Classification	
No Indication	: Ceramic DIP
P	: Plastic DIP
F (FP)	: SOP, FPP
CG	: LCC (8-bit microcomputer device)
Y	: PGA (16-bit microcomputer device)
Z	: LCC (16-bit microcomputer device)

Package Code Indication



(Note) PGA packages of 16-bit microcomputer devices have a different indication.



3. Package Dimensional Outline

Hitachi multi-chip microcomputer devices employ the packages

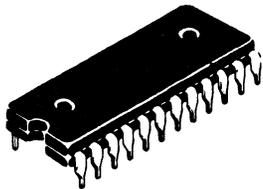
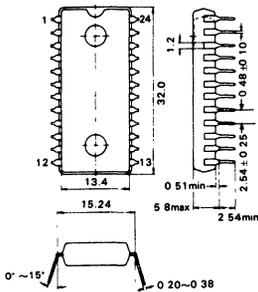
shown in Table 1 according to PCB mounting method.

Table 1 Package List

Method of Mounting	Package Classification		Package Material	Package Code
Pin Insertion Type	Standard Outline (DIP)		Plastic	DP-24 DP-28 DP-40
			Ceramic	DC-48 DC-64
	Shrink Outline	S-DIP	Plastic	DP-64S
		PGA	Glass Sealed Ceramic	PGA-68
Surface Mounting Type	Flat Package	FLAT-DIP (SOP)	Plastic	FP-24
		FLAT-QUIP (FPP)		FP-54 FP-64 FP-80
	Chip Carrier (LCC)			Glass Sealed Ceramic

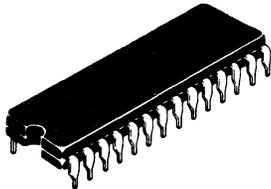
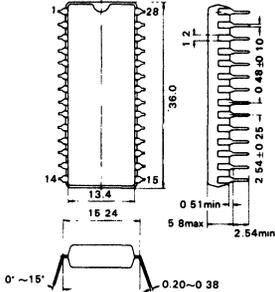
Plastic DIP

● DP-24



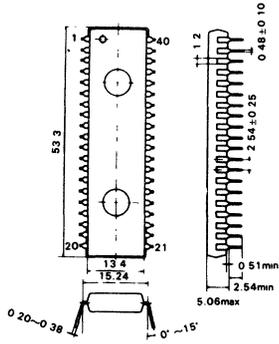
(Unit: mm)

● DP-28



(Unit: mm)

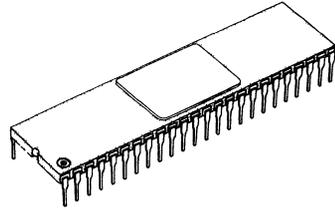
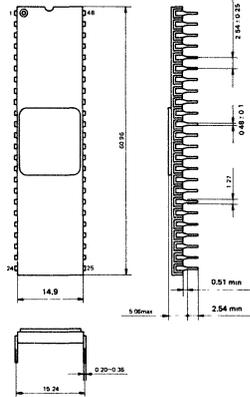
● DP-40



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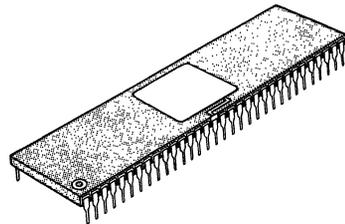
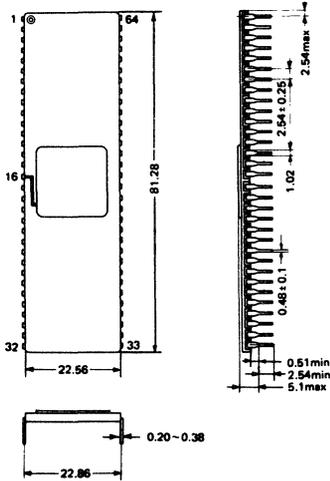
Ceramic DIP

● DC-48



(Unit: mm)

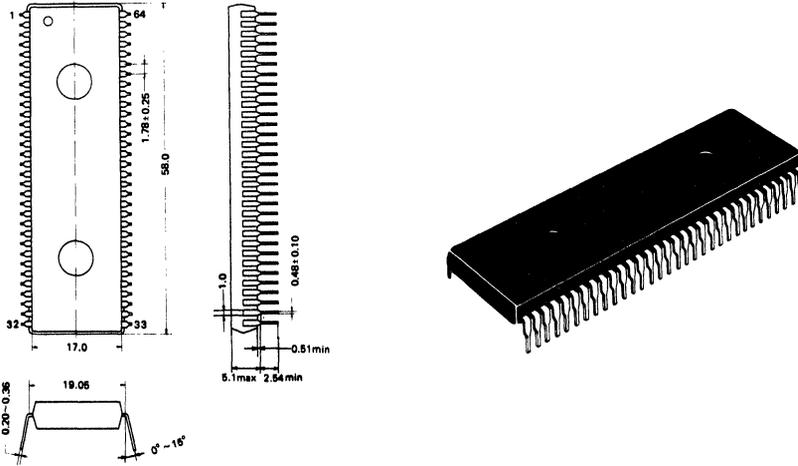
● DC-64



(Unit: mm)

Shrink Type Plastic DIP

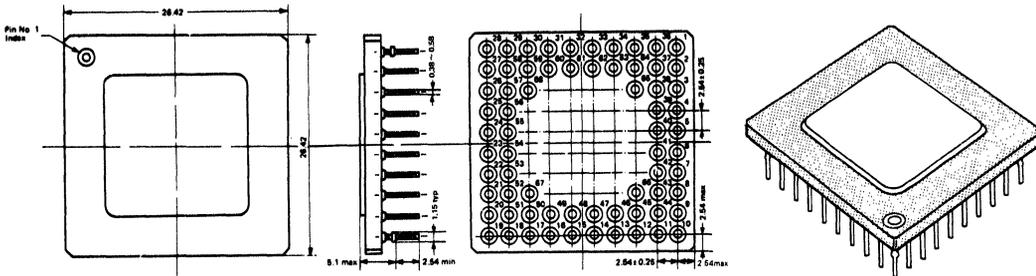
● DP-64S



(Unit: mm)

Pin Grid Array

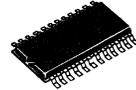
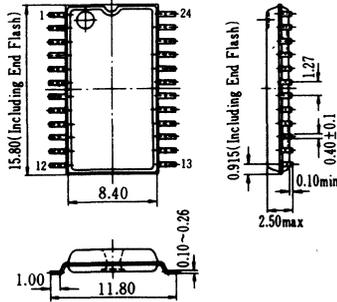
● PGA-68



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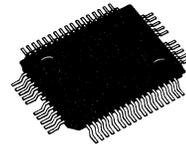
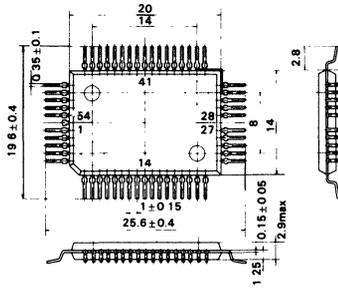
Flat Package

- < SOP >
 ● FP-24



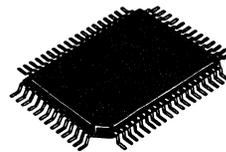
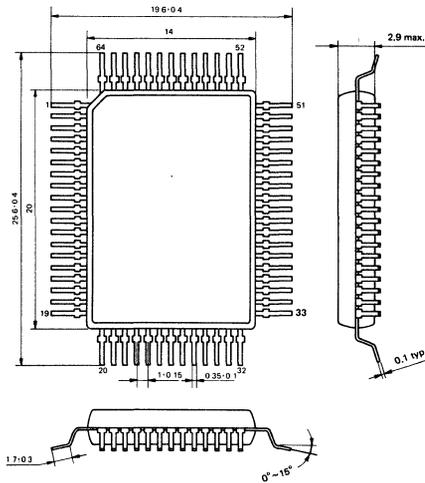
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- < FPP >
 ● FP-54

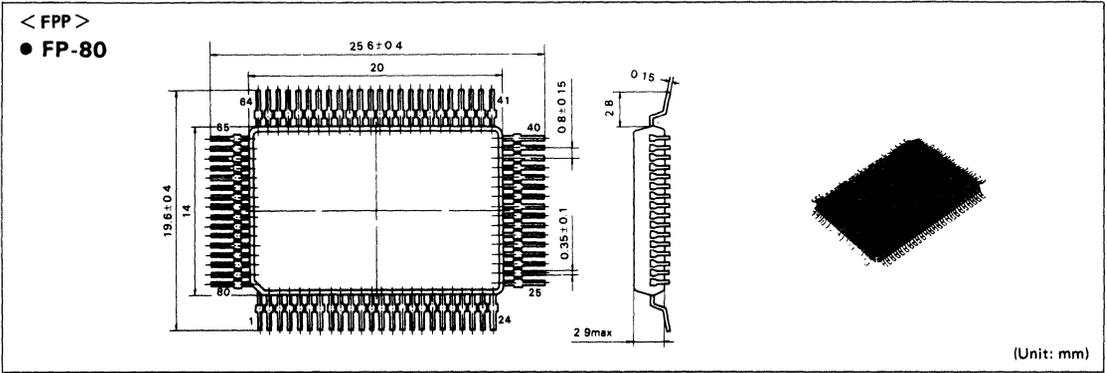


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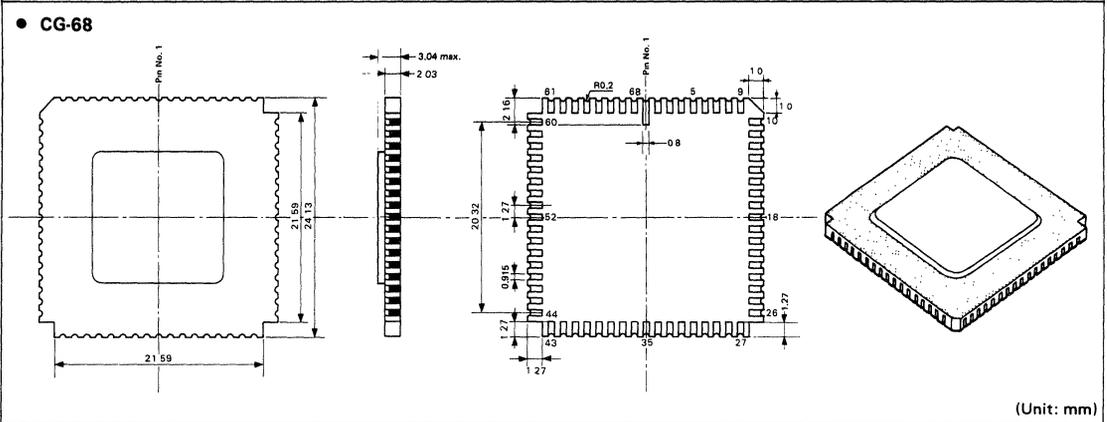
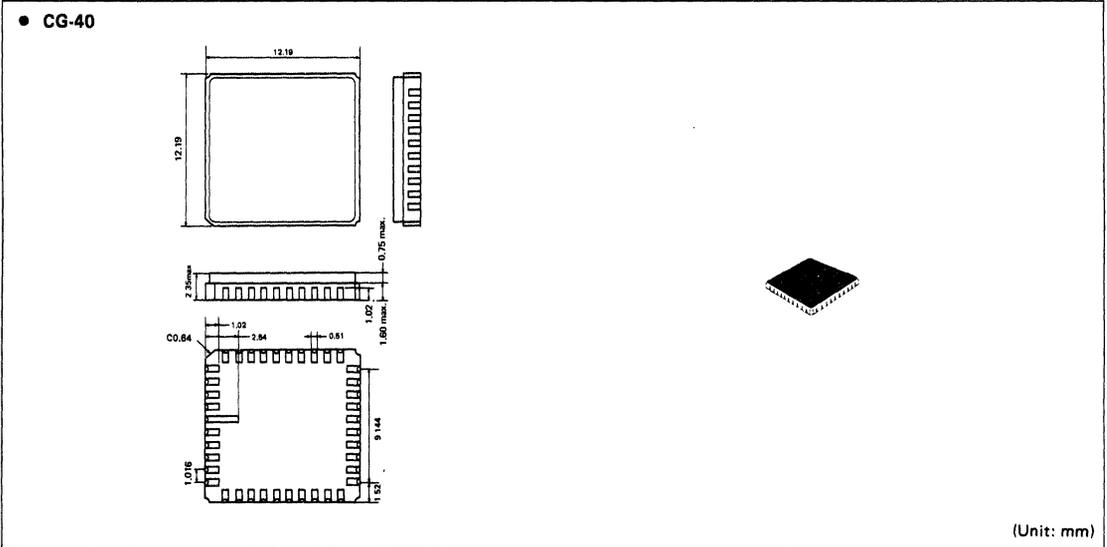
- < FPP >
 ● FP-64



(Unit: mm)



Leadless Chip Carrier



4. Mounting Method

Package lead pins are surface treated with solder coating or plating to facilitate PCB mounting. The lead pins are connected to the package by eutectic solder. Common connecting method of leads and precautions are explained as follows:

4.1 Mounting Methods of Pin Insertion Type Package

Insert lead pins into the PCG through-holes (usually about $\frac{1}{4}0.8\text{mm}$). Soak leads in a wave solder tub.

Lead pins held by the through-holes enable handling of the package through the soldering process, and facilitate automated soldering. When soldering leads in the wave solder tub, do not get solder on the package.

4.2 Mounting Method of Surface Mount Type Package

Apply the specified quantity of solder paste to the pattern on any printed board by the screen printing method, to temporarily fix the package to the board. The solder paste melts when heated in a reflowing furnace, and package leads and the pattern of the printed board are fixed by the surface tension of the melted solder and self alignment.

The size of the pattern where leads are attached should be 1.1 to 1.3 times the leads' width, depending on paste material or furnace adjustment.

The temperature of the reflowing furnace is dependent on packaging material and type. Fig. 2 lists the adjustment of the reflowing furnace for FPP. Pre-heat the furnace to 150°C . Surface temperature of the resin should be kept at 235°C maximum for 10 minutes or less.

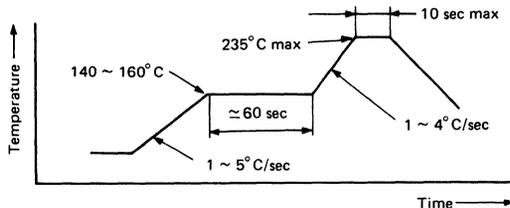


Fig. 2 Reflowing Furnace Adjustment for FPP

Employ adequate heating or temperature control equipment to prevent damage to the plastic package epoxy-resin material. When using an infrared heater, avoid long exposure at temperatures higher than the glass transition point of epoxy-resin (about 150°C), which may cause package damage and loss of reliability characteristics. Equalize the temperature inside and outside of packages by reducing the heat of the upper surface of the packages.

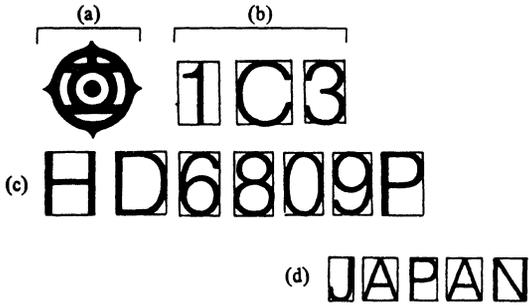
FPP leads may easily bend in shipment or during handling, and impact soldering onto the printed board. Heat the bent leads again with a soldering iron to reshape them.

Use a rosin flux when soldering. Do not use chloric flux because the chlorine in the flux has a tendency to remain on the leads and reduce reliability. Use alcohol, chloroethene or freon to wash away rosin flux from packages. These solvents should not remain on the packages for an excessive length of time, because the package markings may disappear.

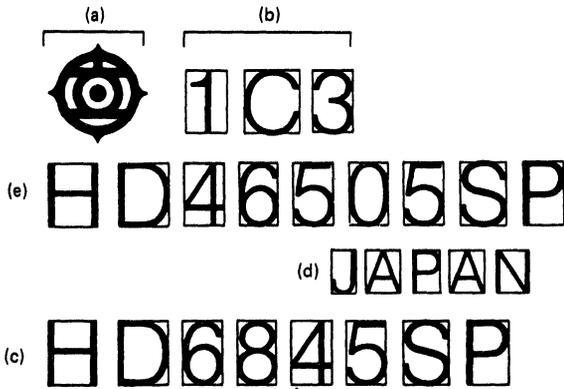
5. Marking

The Hitachi trademark, product type No., and other markings are printed on packages as shown in the following examples. Case I and Case II are examples of markings and Nos. Case I applies to products which have only a standard type No., while Case II applies to products which have an old type No. and a standard type No.

Case I; Includes a standard type No.



Case II; Includes an old type No. and a standard type No.



Meaning of Each Mark

(a)	Hitachi Trademark
(b)	Lot Code
(c)	Standard Type No.
(d)	Japan Mark
(e)	Old Type No.

QUALITY ASSURANCE

1. VIEWS ON QUALITY AND RELIABILITY

Basic views on quality at Hitachi are to meet the individual users' required quality level and maintain a general quality level equal to or above that of the general market. The quality required by the user may be specified by contract, or may be indefinite. In either case, efforts are made to assure reliable performance in actual operating circumstances. Quality control during the manufacturing process, and quality awareness from design through production lead to product quality and customer satisfaction. Our quality assurance technique consists basically of the following steps:

- (1) Build in reliability at the design stage of new product development.
- (2) Build in quality at all steps in the manufacturing process.
- (3) Execute stringent inspection and reliability confirmation of final products.
- (4) Enhance quality levels through field data feed back.
- (5) Cooperate with research laboratories for higher quality and reliability.

With the views and methods mentioned above, utmost efforts are made to meet users' requirements.

2. RELIABILITY DESIGN OF SEMICONDUCTOR DEVICES

2.1 Reliability Targets

The reliability target is an important factor in sales, manufacturing, performance, and price. It is not adequate to set a reliability target based on a single set of common test conditions. The reliability target is set based on many factors:

- (1) End use of semiconductor device.
- (2) End use of equipment in which device is used.
- (3) Device manufacturing process.
- (4) End user manufacturing techniques.
- (5) Quality control and screening test methods.
- (6) Reliability target of system.

2.2 Reliability Design

The following steps are taken to meet the reliability targets:

- (1) Design Standardization

As for design rules, critical items pertaining to quality and reliability are always studied at circuit

design, device design, layout design, etc. Therefore, as long as standardized processing and materials are used the reliability risk is extremely small even in the case of new development devices, with the exception of special requirements imposed by functional needs.

- (2) Device Design

It is important for the device design to consider total balance of process, structure, circuit, and layout design, especially in the case where new processes and/or new materials are employed. Rigorous technical studies are conducted prior to device development.

- (3) Reliability Evaluation by Functional Test

Functional Testing is a useful method for design and process reliability evaluation of IC's and LSI devices which have complicated functions.

The objectives of Functional Test are:

- Determining the fundamental failure mode.
- Analysis of relation between failure mode and manufacturing process.
- Analysis of failure mechanism.
- Establishment of QC points in manufacturing process.

2.3 Design Review

Design Review is an organized method to confirm that a design satisfies the performance required and meets design specifications. In addition, design review helps to insure quality and reliability of the finished products. At Hitachi, design review is performed from the planning stage to production for new products, and also for design changes on existing products. Items discussed and considered at design review are:

- (1) Description of the products based on design documents.
- (2) From the standpoint of each participant, design documents are studied, and for points needing clarification, further investigation will be carried out.
- (3) Specify quality control and test methods based on design documents and drawings.
- (4) Check process and ability of manufacturing line to achieve design goal.
- (5) Preparation for production.
- (6) Planning and execution of sub-programs for design changes proposed by individual specialists,

for test, experiments, and calculations to confirm the design changes.

- (7) Analysis of past failures with similar devices, discussion of methods to prevent them, and planning and execution of test programs to confirm success.

3. QUALITY ASSURANCE SYSTEM

3.1 Activity of Quality Assurance

General views of overall quality assurance in Hitachi are as follows:

- (1) Problems in each individual process should be solved in the process. Therefore, at the finished product stage the potential failure factors have been removed.
- (2) Feedback of information is used to insure a satisfactory level of ability process.

3.2 Quality Approval

To insure quality and reliability, quality approval is carried out at the preproduction stage of device

design, as described in section 2. Our views on quality approval are:

- (1) A third party executes approval objectively from the standpoint of the customer.
- (2) Full consideration is given to past failures and information from the field.
- (3) No design change or process change without QA approval.
- (4) Parts, materials, and processes are closely monitored.
- (5) Control points are established in mass production after studying the process abilities and variables.

3.3 Quality and Reliability Control at Mass Production

Quality control is accomplished through division of functions in manufacturing, quality assurance, and other related departments. The total function flow is shown in Fig. 2. The main points are described below.

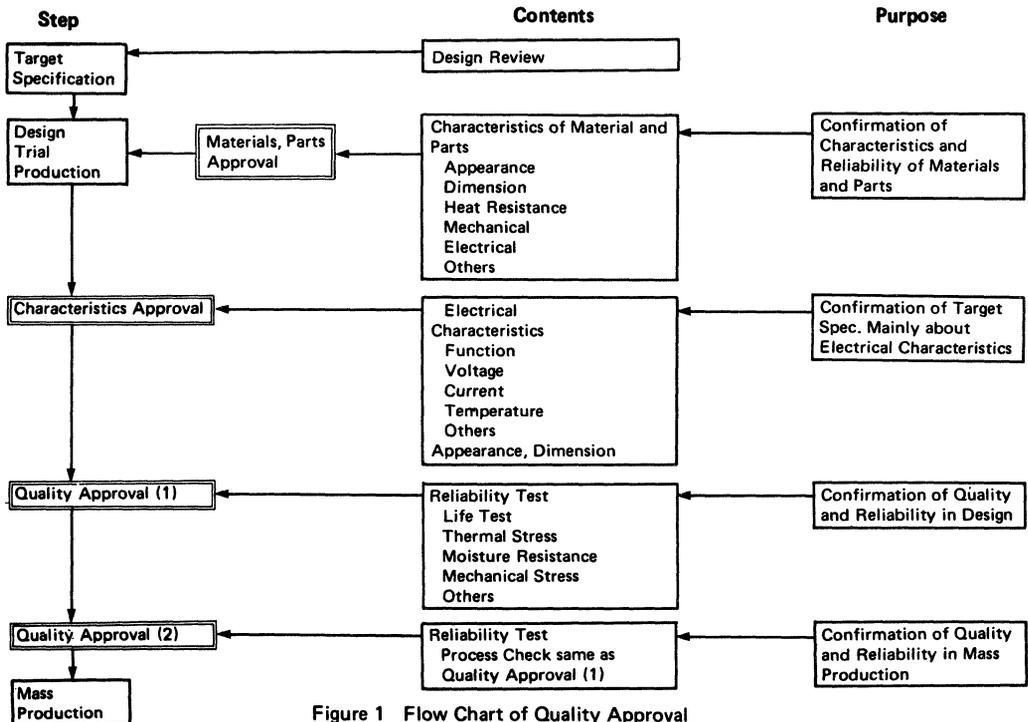


Figure 1 Flow Chart of Quality Approval

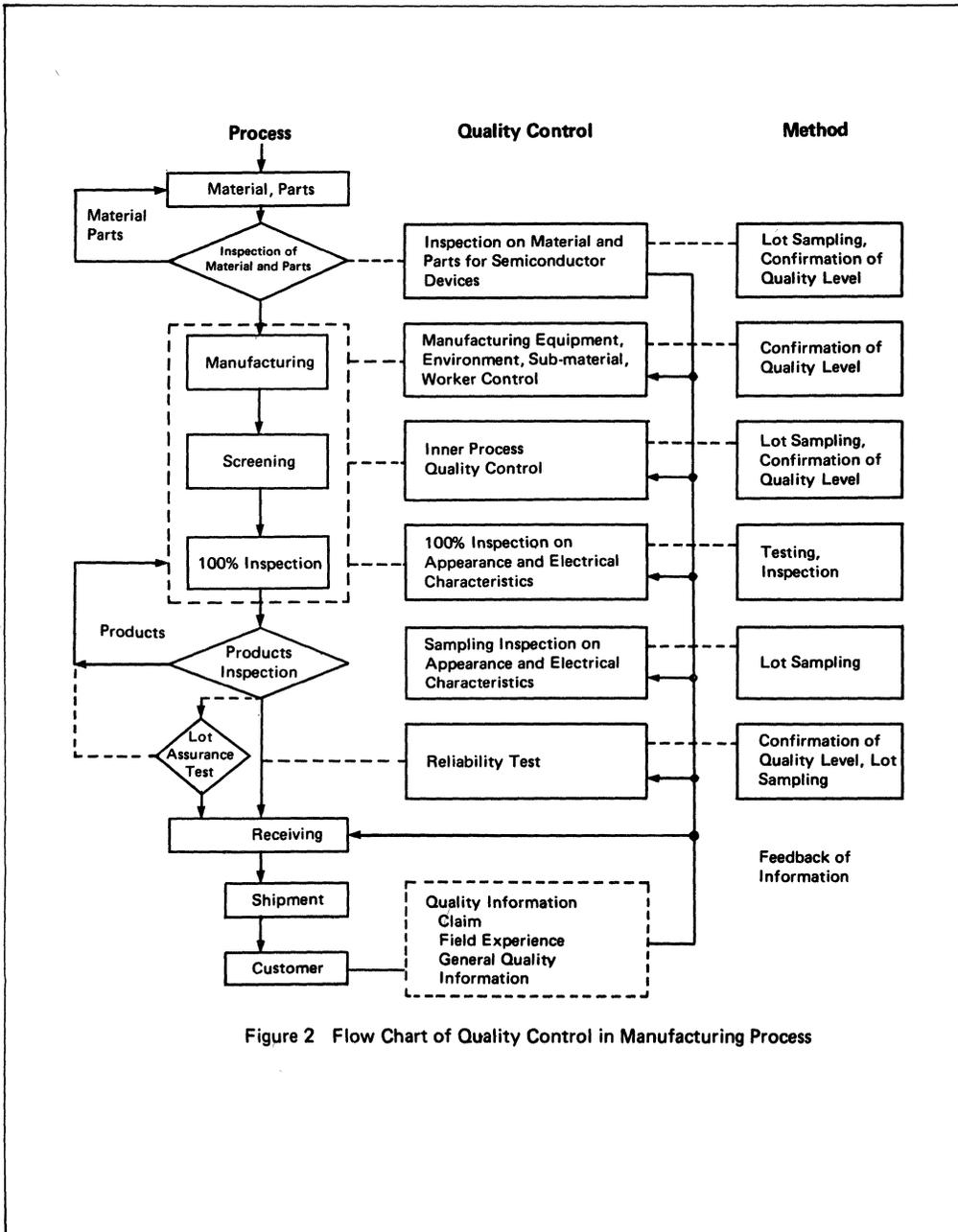


Figure 2 Flow Chart of Quality Control in Manufacturing Process

3.3.1 Quality Control of Parts and Materials

As semiconductor devices tend towards higher performance and higher reliability, the importance of quality control of parts and materials becomes paramount. Items such as crystals, lead frames, fine wire for wire bonding, packages, and materials needed in manufacturing processes such as masks and chemicals, are all subject to rigorous inspection and control. Incoming inspection is performed based on the purchase specification and drawing. The sampling is executed based mainly on MIL-STD-105D.

The other activities of quality assurance are as follows:

- (1) Outside vendor technical information meeting.
- (2) Approval and guidance of outside vendors.
- (3) Chemical analysis and test.

The typical check points of parts and materials are shown in Table 1.

Table 1 Quality Control Check Points of Material and Parts (Example)

Material, Parts	Important Control Items	Point for Check
Wafer	Appearance	Damage and Contamination on Surface
	Dimension Sheet Resistance Defect Density Crystal Axis	Flatness Resistance Defect Numbers
Mask	Appearance Dimension Resistoration Gradation	Defect Numbers, Scratch Dimension Level Uniformity of Gradation
	Appearance	Contamination, Scratch, Bend, Twist
Fine Wire for Wire Bonding	Dimension Purity Elongation Ratio	Purity Level Mechanical Strength
	Appearance Dimension Processing Accuracy Plating Mounting Characteristics	Contamination, Scratch Dimension Level Bondability, Solderability Heat Resistance
Ceramic Package	Appearance Dimension Leak Resistance Plating Mounting Characteristics	Contamination, Scratch Dimension Level Airtightness Bondability, Solderability Heat Resistance
	Electrical Characteristics Mechanical Strength	Mechanical Strength
Plastic	Composition	Characteristics of Plastic Material
	Electrical Characteristics Thermal Characteristics Molding Performance Mounting Characteristics	Molding Performance Mounting Characteristics

3.3.2 Inner Process Quality Control

Inner Process Quality Control performs very important functions in quality assurance of semiconductor devices. The manufacturing Inner Process Quality Control is shown in Fig. 3.

(1) Quality Control of Semi-final Products and Final Products

Potential failure factors of semiconductor devices are removed in the manufacturing process. To achieve this, check points are set-up in each process and products which have potential failure factors are not moved to the next process step. Manufacturing lines are rigidly selected and tight inner process quality controls are executed—rigid checks in each process and each lot, 100% inspection to remove failure factors caused by manufacturing variables and high temperature aging and temperature cycling. Elements of inner process quality control are as follows:

- Condition control of equipment and workers environment and random sampling of semi-final products.
- Suggestion system for improvement of work.
- Education of workers.
- Maintenance and improvement of yield.
- Determining quality problems, and implementing countermeasures.
- Transfer of quality information.

(2) Quality Control of Manufacturing Facilities and Measuring Equipment

Manufacturing equipment is improving as higher performance devices are needed. At Hitachi, the automation of manufacturing equipment is encouraged. Maintenance Systems maintain operation of high performance equipment. There are daily inspections which are performed based on related specifications. Inspection points are listed in the specification and are checked one by one to prevent any omission. As for adjustment and maintenance of measuring equipment, specifications are checked one by one to maintain and improve quality.

(3) Quality Control of Manufacturing Circumstances and Sub-Materials

The quality and reliability of semiconductor devices are highly affected by the manufacturing process. Therefore, controls of manufacturing circum-

stances such as temperature, humidity and dust, and the control of submaterials, like gas, and pure water used in a manufacturing process, are intensively executed.

Dust control is essential to realize higher integration and higher reliability of devices. At Hitachi, maintenance and improvement of cleanliness at manufacturing sites is accomplished through

attention to buildings, facilities, air conditioning systems, delivered materials, clothes, work environment, and periodic inspection of floating dust concentration.

3.3.3 Final Product Inspection and Reliability Assurance

(1) Final Product Inspection

Lot inspection is done by the quality assurance

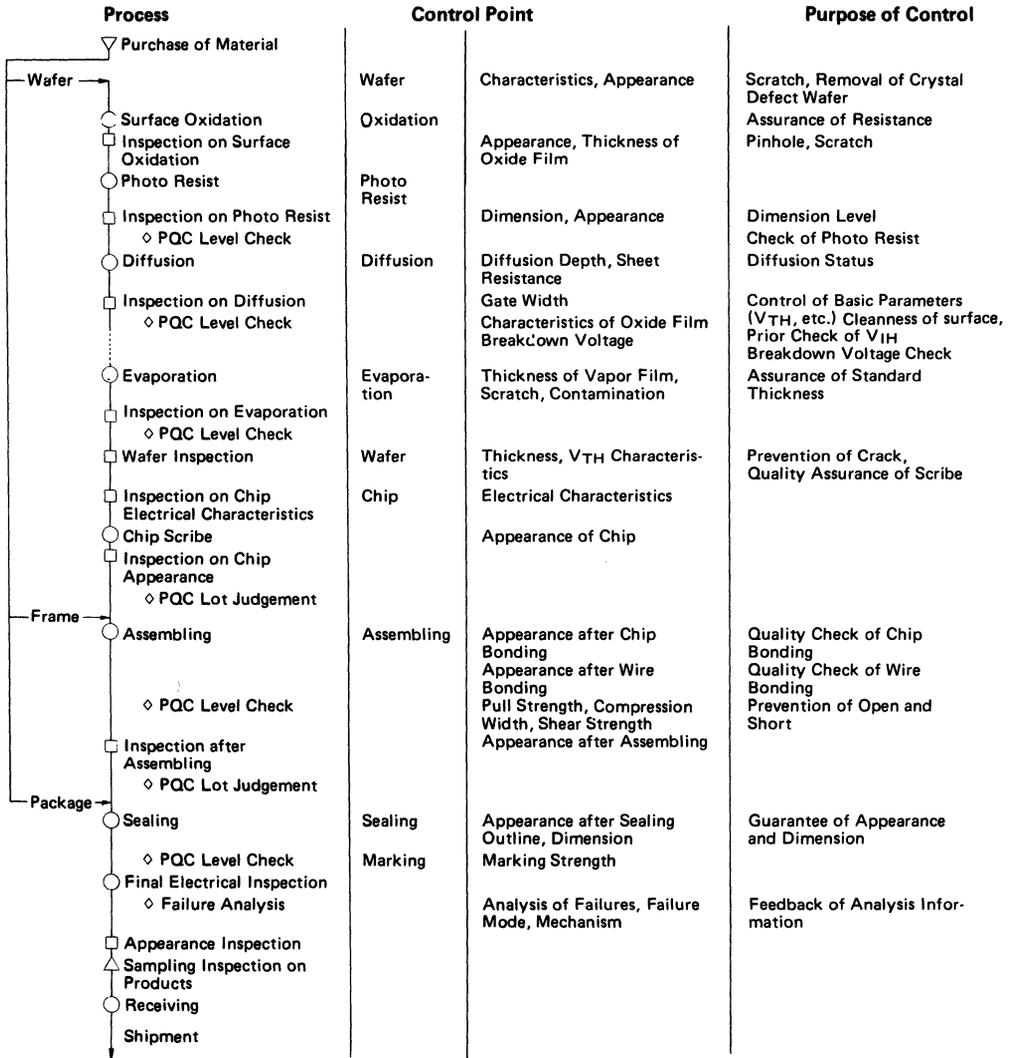


Figure 3 Example of Inner Process Quality Control

department for products which were judged good in 100% test . . . the final process in manufacturing. Though 100% yield is expected, sampling inspection is executed to prevent mixture of bad product by mistake. The inspection is executed not only to confirm that the products have met the users' requirements but also to consider potential

quality factors. Lot inspection is executed based on MIL-STD-105D.

(2) Reliability Assurance Tests

To assure the reliability of semiconductor devices, reliability tests and tests on individual manufacturing lots that are required by the user, are periodically performed.

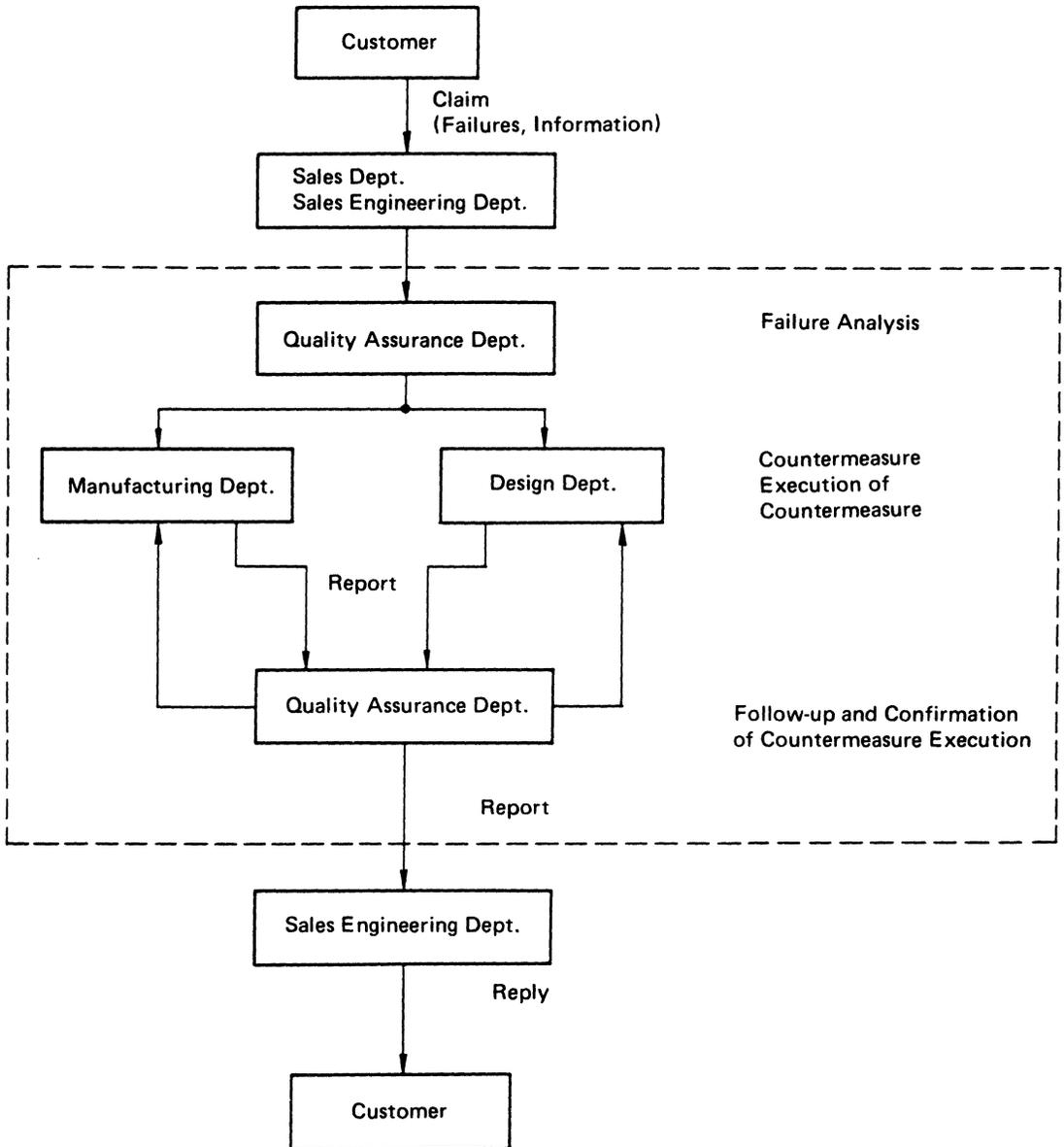


Figure 4 Process Flow Chart of Field Failure

RELIABILITY TEST DATA

1. INTRODUCTION

Microcomputers provide high reliability and quality to meet the demands of increased function, enlarging scale, and widening application. Hitachi has improved the quality level of microcomputer products by evaluating reliability, building quality into the manufacturing process, strengthening inspection techniques, and analyzing field data.

The following reliability and quality assurance data for Hitachi 8-bit and 16-bit multi-chip microcomputers indicates results from test and failure analysis.

2. PACKAGE AND CHIP STRUCTURE

2.1 Packaging

Production output and application of plastic packaging continues to increase, expanding to automobile measuring and control systems, and computer terminal equipment operating under severe conditions. To meet this demand, Hitachi has significantly improved moisture resistance and operational stability in the plastic manufacturing process.

Plastic and side-brazed ceramic package structures are shown in Figure 1 and Table 1.

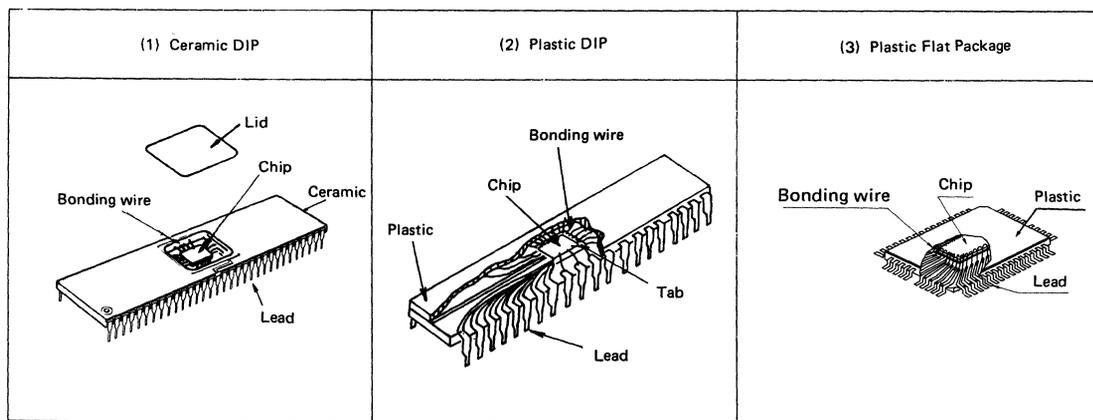


Figure 1 Package Structure

Table 1 Package Material and Properties

Item	Ceramic DIP	Plastic DIP	Plastic Flat Package
Package	Alumina	Epoxy	Epoxy
Lead	Tin plating Brazed Alloy 42	Solder dipping Alloy 42	Solder plating Alloy 42
Seal	Au-Sn Alloy	N.A	N.A
Die bond	Au-Si	Au-Si or Ag paste	Au-Si or Ag paste
Wire bond	Ultrasonic	Thermo compression	Thermo compression
Wire	Al	Au	Au

2.2 Chip Structure

Hitachi microcomputers are produced in NMOS E/D technology or low power CMOS technology. Si-gate process is used

in both types to achieve high reliability and density.

Chip structure and basic circuit are shown in Figure 2.

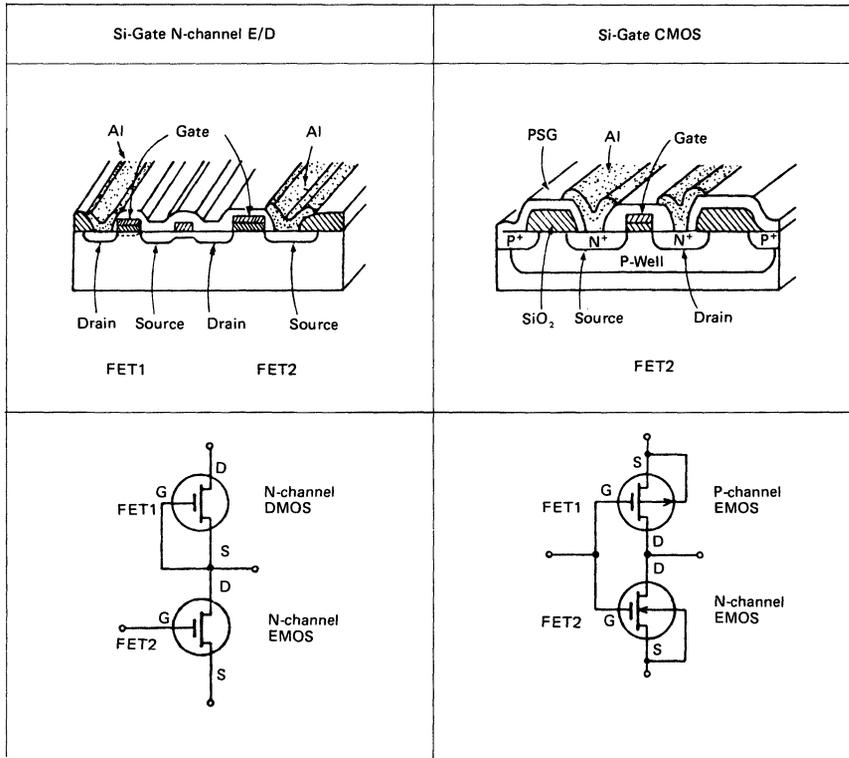


Figure 2 Chip Structure and Basic Circuit

3. QUALITY QUALIFICATION AND EVALUATION

3.1 Reliability Test Methods

Reliability test methods shown in Table 2 are used to qualify and evaluate new products and processes.

Table 2 Reliability Test Methods

Test Items	Test Condition	MIL-STD-883B Method No.
Operating Life Test	125°C, 1000hr	1005,2
High Temp, Storage Low Temp, Storage Steady State Humidity Steady State Humidity Biased	Tstg max, 1000hr Tstg min, 1000hr 65°C 95%RH, 1000hr 85°C 85%RH, 1000hr	1008,1
Temperature Cycling	-55°C ~ 150°C, 10 cycles	1010,4
Temperature Cycling	-20°C ~ 125°C, 200 cycles	
Thermal Shock	0°C ~ 100°C, 100 cycles	1011,3
Soldering Heat	260°C, 10 sec	
Mechanical Shock	1500G 0.5 msec, 3 times/X, Y, Z	2002,2
Vibration Fatigue	60Hz 20G, 32hrs/X, Y, Z	2005,1
Variable Frequency	20~2000Hz 20G, 4 min/X, Y, Z	2007,1
Constant Acceleration	20000G, 1 min/X, Y, Z	2001,2
Lead Integrity	225gr, 90° 3 times	2004,3

3.2 Reliability Test Result

Reliability Test Results of 8-bit multi-chip microcomputer

devices is shown in Table 3 to Table 7, and of 16-bit microprocessor HD68000 in Table 8, Table 9.

Table 3 Dynamic Life Test (8-bit multi-chip microcomputer)

Device	Sample Size	Component Hour	Failure
HD6800	248	248000	0
HD6802	452	153712	1*
HD6809	85	85000	0
HD6821	399	266368	1*
HD6850	158	158000	0
HD6852	170	125816	0
HD6846	69	69000	0
HD6843	66	66000	0
HD6844	80	69000	0
HD6845S	88	55000	0
HD6840	64	64000	0
HD46508	140	140000	0
HD146818	44	44000	0
Total	2063	1543896	2

* Current leakage

Table 4 High Temperature, High Humidity Test (8-bit multi-chip microcomputer) (Moisture Resistance Test)

(1) 85°C 85%RH Bias Test

Device	V _{CC} Bias	168 hrs	500 hrs	1000 hrs
HD6800P	5.5V	0/45	0/45	0/45
HD6802P	5.5V	0/38	0/38	—
HD6809P	5.5V	0/22	0/22	0/22
HD6850P	5.5V	0/45	0/45	0/45
HD6852P	5.5V	0/22	0/22	—
HD6843P	5.5V	0/22	0/22	—
HD6844P	5.5V	0/22	0/22	—
HD6845SP	5.5V	0/137	0/137	0/137
HD6840P	5.5V	0/22	0/22	—
HD46508P	5.5V	0/22	0/22	—
HD146818P	5.5V	0/22	0/22	0/22
Total		0/419	0/419	0/271

(2) High Temperature, High Humidity Storage Life Test

Device	Condition	168 hrs	500 hrs	1000 hrs
HD6800P	65°C 95%RH	0/22	0/22	0/22
HD6802P	80°C 90%RH	0/22	0/22	0/22
HD6802P	65°C 95%RH	0/38	0/38	—
HD6809P	65°C 95%RH	0/45	0/45	0/45
HD6850P	65°C 95%RH	0/135	0/135	0/135
HD6850P	80°C 90%RH	0/22	0/22	0/22
HD6852P	85°C 95%RH	0/22	0/22	—
HD6843P	80°C 95%RH	0/22	0/22	0/22
HD6844P	80°C 90%RH	0/22	0/22	—
HD6845SP	80°C 90%RH	0/22	0/22	0/22
HD6840P	65°C 95%RH	0/22	0/22	0/22
HD46508P	65°C 95%RH	0/70	0/70	0/70
HD146818P	65°C 95%RH	0/45	0/45	0/45

(3) Pressure Cooker Test (121°C, 2 atm)

Device	40 hrs	60 hrs	100 hrs	200 hrs
HD6800P	0/42	0/42	0/42	—
HD6802P	0/22	0/22	0/22	—
HD6821P	0/44	0/44	0/44	—
HD6850P	0/22	0/22	0/22	—
HD6843P	0/22	0/22	0/22	—
HD6845SP	0/43	0/43	0/43	1*/43
HD6846P	0/13	0/13	0/13	—
HD46508P	0/45	0/45	0/45	—
HD146818P	0/22	0/22	0/22	—

* Aluminum corrosion

(4) MIL-STD-883B Moisture Resistance Test (65°C ~ -10°C, 90%RH or more, V_{CC}=5.5V)

Device	10 cycles	20 cycles	40 cycles
HD6800P	0/25	0/25	0/25
HD6802P	0/25	0/25	0/25
HD6821P	0/25	0/25	0/25
HD6846P	0/25	0/25	0/25

Table 5 Temperature Cycling Test (8-bit multi-chip microcomputer) (-55°C ~ 25°C ~ 150°C)

Device	10 cycles	100 cycles	200 cycles
HD6800P	0/453	0/44	0/44
HD6802P	0/502	0/77	0/77
HD6809P	0/202	0/45	0/45
HD6821P	0/420	0/44	1*/44
HD6850P	0/151	0/38	0/38
HD6852P	0/149	0/38	0/38
HD6843P	0/247	0/44	0/44
HD6844P	0/150	0/44	0/44
HD6845SP	0/358	0/76	0/76
HD6846P	0/150	0/22	0/22
HD6840P	0/148	0/22	0/22
HD46508P	0/207	0/44	0/44
HD146818P	0/103	0/22	0/22

* Large current leakage

Table 6 High Temperature, Low Temperature Storage Life Test (8-bit multi-chip microcomputer)

Device	Temperature	168 hrs	500 hrs	1000 hrs
MPU total	150°C	0/88	0/88	0/88
	-55°C	0/76	0/76	0/76
Peripheral total	150°C	0/110	0/110	0/110
	-55°C	0/88	0/88	0/88

Table 7 Mechanical and Environmental Test (8-bit multi-chip microcomputer)

Test Item	Condition	Plastic DIP		24, 28, 40 pin Ceramic DIP		Flat Plastic Package	
		Sample Size	Failure	Sample Size	Failure	Sample Size	Failure
Thermal Shock	0°C ~ 100°C 10 cycles	110	0	175	0	100	0
Soldering Heat	260°C, 10 sec.	164	0	177	0	20	0
Salt Water Spray	35°C, NaCl 5% 24 hrs	110	0	176	0	20	0
Solderability	230°C, 5 sec. Rosin flux	159	0	137	0	34	0
Drop Test	75cm, maple board 3 times	110	0	—	—	20	0
Mechanical Shock	1500G, 0.5 ms 3 times/X, Y, Z	110	0	189	0	20	0
Vibration Fatigue	60 Hz, 20G 32 hrs/X, Y, Z	110	0	167	0	20	0
Vibration Variable Freq.	100 ~ 2000 Hz 20G, 4 times/X, Y, Z	110	0	167	0	20	0
Lead Integrity	225 g, 90° Bonding 3 times	110	0	102	0	20	0

Table 8 Dynamic Life Test (HD68000)

Condition		168 hrs	500 hrs	1000 hrs
Temperature	V _{CC}			
125°C	5.5V	0/62	0/62	0/62
150°C	5.5V	0/52	0/52	0/52

Table 9 Mechanical and Environmental Test (HD68000)

Test Item	Condition	Sample Size	Failure
High Temp. Storage	T _a = 295°C 1000 hrs	42	0
Low Temp. Storage	T _a = -55°C 1000 hrs	42	0
Temperature Cycling I	-55°C ~ 25°C ~ 150°C 10 cycles	189	0
Temperature Cycling II	-20°C ~ 25°C ~ 125°C 500 cycles	44	0
Thermal Shock	-55°C ~ 125°C 15 cycles	44	0
Soldering Heat	260°C, 10 sec.	44	0
Solderability	230°C, 5 sec.	44	0
Mechanical Shock	1500G, 0.5 ms 3 times/X, Y, Z	44	0
Vibration Variable Freq.	20 ~ 2000 Hz 20 G, 3 times/X, Y, Z	44	0
Constant Acceleration	20000G 1 min/X, Y, Z	44	0

4. PRECAUTIONS

4.1 Storage

To prevent deterioration of electrical characteristics, solderability, appearance or structure, Hitachi recommends semiconductor devices be stored as follows:

- (1) Store in ambient temperatures of 5 to 30° C, with a relative humidity of 40 to 60%.
- (2) Store in a clean, dust- and active gas-free environment.
- (3) Store in conductive containers to prevent static electricity.
- (4) Store without any physical load.
- (5) When storing devices for an extended period, store in an unfabricated form, to minimize corrosion of pre-formed lead wires.
- (6) Unsealed chips should be stored in a cool, dry, dark and dust-free environment. Assembly should be performed within 5 days of unpacking. Devices can be stored for up to 20 days in dry nitrogen gas with a dew point at -30° C or less.
- (7) Prevent condensation during storage due to rapid temperature changes.

4.2 Transportation

General precautions for electronic components are applicable in transporting semiconductors, units incorporating semiconductors, and other similar systems. In addition, Hitachi recommends the following:

- (1) When transporting semiconductor devices or printed circuit boards, minimize mechanical vibration and shock. Use containers or jigs which will not induce static electricity as a result of vibration. Use of an electrically conductive container or aluminum foil is recommended.
- (2) To prevent device deterioration from clothing-induced static electricity, workers should be properly grounded while handling devices. Use of a 1 M ohm resistor is recommended to prevent electric shock.
- (3) When transporting printed circuit boards containing semiconductor devices, suitable preventive measures against static electricity must be taken. Voltage build-up can be avoided by shorting the card-edge terminals. When a belt conveyor is used, apply some surface treatment to prevent build-up of electrical charge.
- (4) Minimize mechanical vibration and shock when transporting semiconductor devices or printed circuit boards.

4.3 Handling for Measurement

Avoid static electricity, noise and voltage surge when measuring or mounting devices. Precaution should be taken against current leakage through terminals and housings of curve tracers, synchrosopes, pulse generators, and DC power sources.

When testing devices, prevent voltage surges from the tester, attached clamping circuit, and any excessive voltage possible through accidental contact.

In inspecting a printed circuit board, power should not be applied if any solder bridges or foreign matter is present.

4.4 Soldering

Semiconductor devices should not be exposed to high temperatures for excessive periods. Soldering must be performed consistent with temperature conditions of 260° C for 10 seconds, 350° C for 3 seconds, and at a distance of 1 to 1.5mm from the end of the device package.

A soldering iron with secondary voltage supplied through a grounded transformer is recommended to protect against leakage current. Use of alkali or acid flux, which may corrode the leads, is not recommended.

4.5 Removing Residual Flux

Detergent or ultrasonic removal of residual flux from circuit boards is necessary to ensure system reliability. Selection of detergent type and cleaning conditions are important factors.

When chloric detergent is used for plastic packaged devices, care must be taken against package corrosion. Extended cleaning periods and excessive temperature conditions can cause the chip coating to swell due to solvent permeation. Hitachi recommends use of Lotus and Dyfron solvents. Trichloroethylene solvent is not suitable.

The following conditions are advisable for ultrasonic cleaning:

- Frequency: 28 to 29 k Hz (to avoid device resonance)
- Ultrasonic output: 15W/1
- Keep devices from making direct contact with power generator
- Cleaning time: Less than 30 seconds.

DATA SHEETS

**8-BIT MULTI-CHIP
MICROCOMPUTERS**

Preliminary data sheets herein contain information on new products. Specifications and information are subject to change without notice.

Advance Information data sheets herein contain information on products under development. Hitachi reserves the right to change or discontinue these products without notice.

HD6803, HD6803-1

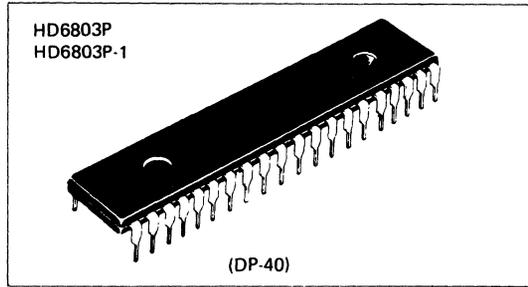
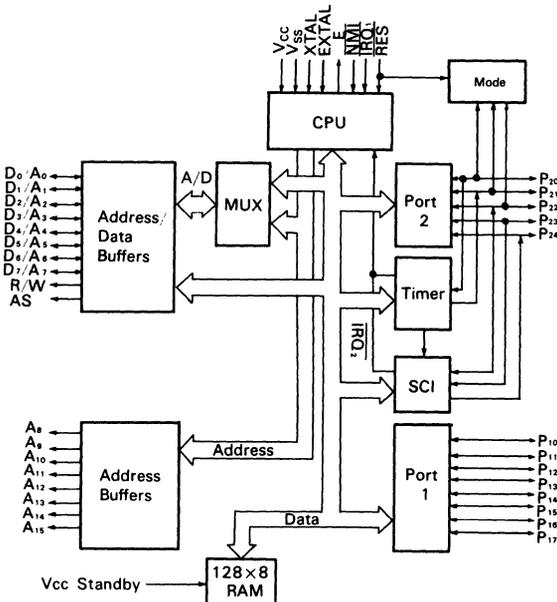
MPU (Micro Processing Unit)

The HD6803 MPU is an 8-bit microcomputer system which is compatible with the HMCS6800 family of parts. The HD6803 MPU is object code compatible with the HD6800 with improved execution times of key instructions plus several new 16-bit and 8 bit instruction including an 8×8 unsigned multiply with 16-bit result. The HD6803 MPU can be expanded to 65k words. The HD6803 MPU is TTL compatible and requires one +0.5 volt power supply. The HD6803 MPU has 128 bytes of RAM, Serial Communications Interface (S.C.I.), and parallel I/O as well as a three function 16-bit timer. Features and Block Diagram of the HD6803 include the following:

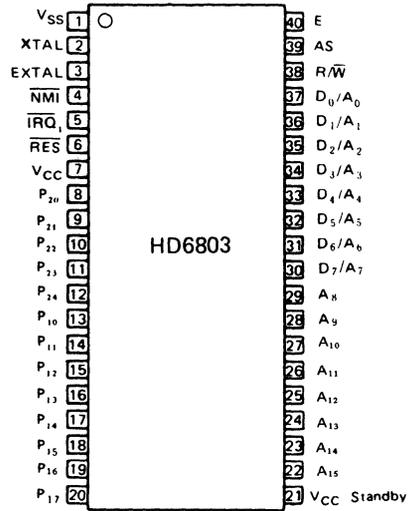
■ FEATURES

- Expanded HMCS6800 Instruction Set
- 8×8 Multiply
- On-Chip Serial Communications Interface (S.C.I.)
- Object Code Compatible with The HD6800 MPU
- 16-Bit Timer
- Expandable to 65k Words
- Multiplexed Address and Data
- 128 Bytes of RAM (64 Bytes Retainable On Power Down)
- 13 Parallel I/O Lines
- Internal Clock/Divided-By-Four
- TTL Compatible Inputs and Outputs
- Interrupt Capability
- Compatible with MC6803 and MC6803-1

■ BLOCK DIAGRAM



■ PIN ARRANGEMENT



(Top View)

■ TYPE OF PRODUCTS

Type No.	Bus Timing
HD6803	1.0MHz
HD6803-1	1.25MHz

■ ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Value	Unit
Supply Voltage	V_{CC}^*	-0.3 ~ +7.0	V
Input Voltage	V_{in}^*	-0.3 ~ +7.0	V
Operating Temperature	T_{opr}	0 ~ +70	°C
Storage Temperature	T_{str}	-55 ~ +150	°C

* With respect to V_{SS} (SYSTEM GND)

[NOTE] Permanent LSI damage may occur if maximum ratings are exceeded. Normal operation should be under recommended operating conditions. If these conditions are exceeded, it could affect reliability of LSI.

■ ELECTRICAL CHARACTERISTICS

● DC CHARACTERISTICS ($V_{CC} = 5.0V \pm 5\%$, $V_{SS} = 0V$, $T_a = 0 \sim +70^\circ C$, unless otherwise noted.)

Item	Symbol	Test Condition	min	typ	max	Unit
Input "High" Voltage	RES	V_{IH}	4.0	-	V_{CC}	V
	Other Inputs*		2.0	-	V_{CC}	
Input "Low" Voltage	All Inputs*	V_{IL}	-0.3	-	0.8	V
Input Load Current	EXTAL	$ I_{in} $	$V_{in} = 0 \sim V_{CC}$		0.8	mA
Input Leakage Current	\overline{NMI} , $\overline{IRQ_1}$, \overline{RES}	$ I_{in} $	$V_{in} = 0 \sim 5.25V$		2.5	μA
Three State (Offset) Leakage Current	$P_{10} \sim P_{17}$	$ I_{TSI} $	$V_{in} = 0.5 \sim 2.4V$		10	μA
	$P_{20} \sim P_{24}$		-	-	100	
Output "High" Voltage	$D_0/A_0 \sim D_7/A_7$	V_{OH}	$I_{LOAD} = -205 \mu A$	2.4	-	V
	$A_8 \sim A_{15}$, E, R/W, AS		$I_{LOAD} = -145 \mu A$	2.4	-	
	Other Outputs		$I_{LOAD} = -100 \mu A$	2.4	-	
Output "Low" Voltage	All Outputs	V_{OL}	$I_{LOAD} = 1.6 mA$		0.5	V
Darlington Drive Current	$P_{10} \sim P_{17}$	$-I_{OH}$	$V_{out} = 1.5V$		10.0	mA
Power Dissipation		P_D	-	-	1200	mW
Input Capacitance	$A_0/D_0 \sim A_7/D_7$	C_{in}	$V_{in} = 0V$, $T_a = 25^\circ C$, $f = 1.0 MHz$		12.5	pF
	Other Inputs		-	-	10.0	
V_{CC} Standby	Powerdown	V_{SBB}	4.0	-	5.25	V
	Operating	V_{SB}	4.75	-	5.25	
Standby Current	Powerdown	I_{SBB}	$V_{SBB} = 4.0V$		8.0	mA

*Except Mode Programming Levels.

● AC CHARACTERISTICS

BUS TIMING ($V_{CC} = 5.0V \pm 5\%$, $V_{SS} = 0V$, $T_a = 0 \sim +70^\circ C$, unless otherwise noted.)

Item	Symbol	Test Condition	HD6803			HD6803-1			Unit	
			min	typ	max	min	typ	max		
Cycle Time	t_{cyc}	Fig. 1	1	—	10	0.8	—	10	μs	
Address Strobe Pulse Width "High"	PW_{ASH}		200	—	—	150	—	—	ns	
Address Strobe Rise Time	t_{ASr}		5	—	50	5	—	50	ns	
Address Strobe Fall Time	t_{ASf}		5	—	50	5	—	50	ns	
Address Strobe Delay Time	t_{ASD}		60	—	—	30	—	—	ns	
Enable Rise Time	t_{Er}		5	—	50	5	—	50	ns	
Enable Fall Time	t_{Ef}		5	—	50	5	—	50	ns	
Enable Pulse Width "High" Time	PW_{EH}		450	—	—	340	—	—	ns	
Enable Pulse Width "Low" Time	PW_{EL}		450	—	—	350	—	—	ns	
Address Strobe to Enable Delay Time	t_{ASED}		60	—	—	30	—	—	ns	
Address Delay Time	t_{AD}		—	—	260	—	—	260	ns	
Address Delay Time for Latch	t_{ADL}		—	—	270	—	—	260	ns	
Data Set-up Write Time	t_{DSW}		225	—	—	115	—	—	ns	
Data Set-up Read Time	t_{DSR}		80	—	—	70	—	—	ns	
Data Hold Time	Read		t_{HR}	10	—	—	10	—	—	ns
	Write		t_{HW}	20	—	—	20	—	—	
Address Set-up Time for Latch	t_{ASL}		60	—	—	50	—	—	ns	
Address Hold Time for Latch	t_{AHL}	20	—	—	20	—	—	ns		
Address Hold Time	t_{AH}	20	—	—	20	—	—	ns		
Peripheral Read Access Time (Multiplexed Bus)	(t_{ACCM})	—	—	(600)	—	—	(420)	ns		
Oscillator stabilization Time	t_{RC}	Fig. 7	100	—	—	100	—	—	ms	
Processor Control Set-up Time	t_{PCS}	Fig. 8	200	—	—	200	—	—	ns	

PERIPHERAL PORT TIMING ($V_{CC} = 5.0V \pm 5\%$, $V_{SS} = 0V$, $T_a = 0 \sim +70^\circ C$, unless otherwise noted.)

Item		Symbol	Test Condition	min	typ	max	Unit
Peripheral Data Setup Time	Port 1, 2	t_{PDSU}	Fig. 2	200	—	—	ns
Peripheral Data Hold Time	Port 1, 2	t_{PDH}	Fig. 2	200	—	—	ns
Delay Time, Enable Negative Transition to Peripheral Data Valid	Port 1, 2*	t_{PWD}	Fig. 3	—	—	400	ns

* Except P₂₁

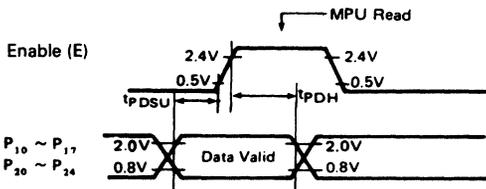


Figure 2 Data Set-up and Hold Times (MPU Read)

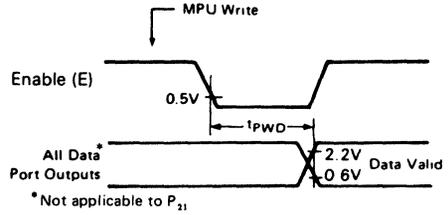


Figure 3 Port Data Delay Timing (MPU Write)

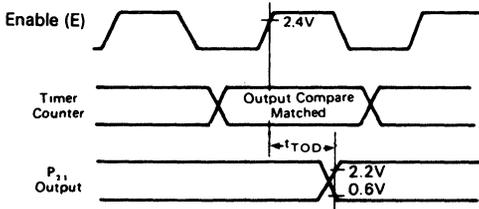


Figure 4 Timer Output Timing

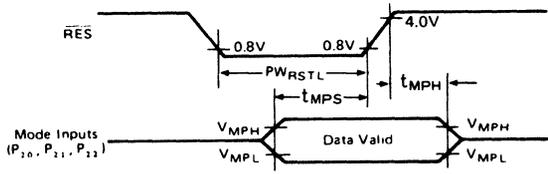


Figure 5 Mode Programming Timing

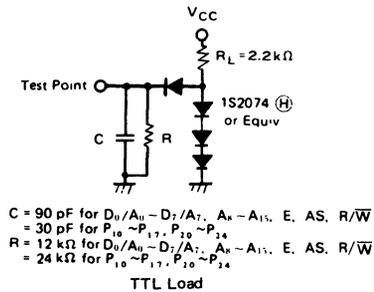


Figure 6 Bus Timing Test Load

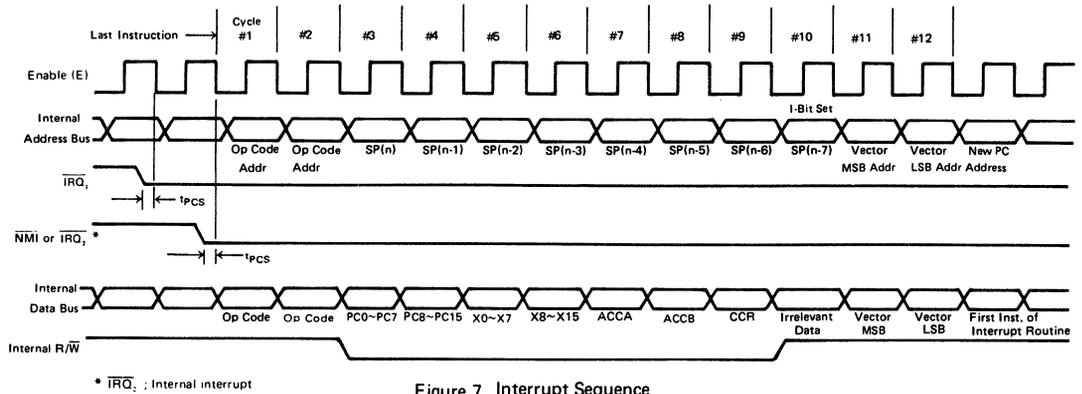


Figure 7 Interrupt Sequence

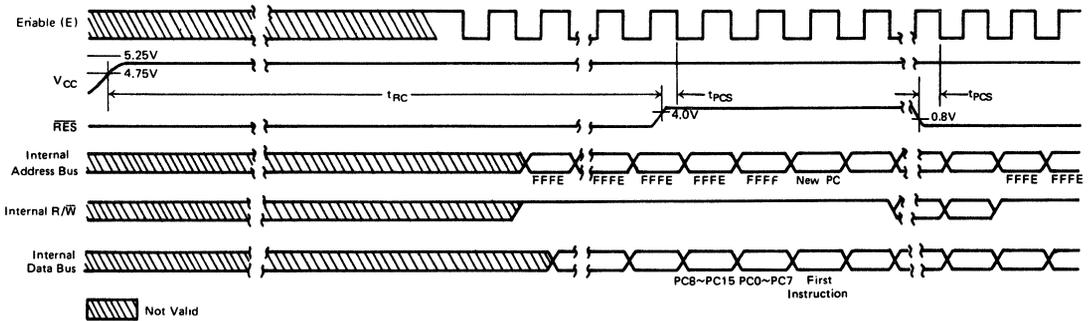


Figure 8 Reset Timing

■ SIGNAL DESCRIPTIONS

● Vcc and Vss

These two pins are used to supply power and ground to the chip. The voltage supplied will be +5 volts ±5%.

● XTAL and EXTAL

These connections are for a parallel resonant fundamental crystal, AT cut. Divided by 4 circuitry is included with the internal clock, so a 4 MHz crystal may be used to run the system at 1 MHz. The device by 4 circuitry allows for use of the inexpensive 3.58 MHz Color TV crystal for non-time critical applications. Two 22pF capacitors are needed from the two crystal pins to ground to insure reliable operation. EXTAL may be driven by an external TTL compatible source with a 50% (±10%) duty cycle. It will divided by 4 any frequency less than or equal to 5 MHz. XTAL must be grounded if an external clock is used. The following are the recommended crystal parameters:

Nominal Crystal Parameter

Crystal Item	4 MHz	5 MHz
C _O	7pF max.	4.7pF max.
R _S	60Ω max.	30Ω typ.

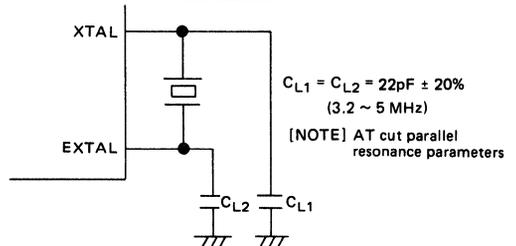


Figure 9 Crystal Interface

• **V_{CC} Standby**

This pin will supply +5 volts ±5% to the standby RAM on the chip. The first 64 bytes of RAM will be maintained in the power down mode with 8 mA current max. The circuit of figure 13 can be utilized to assure that V_{CC} Standby does not go below V_{SBB} during power down.

To retain information in the RAM during power down the following procedure is necessary:

- 1) Write "0" into the RAM enable bit, RAM E. RAM E is bit 6 of the RAM Control Register at location \$0014. This disables the standby RAM, thereby protecting it at power down.
- 2) Keep V_{CC} Standby greater than V_{SBB}.

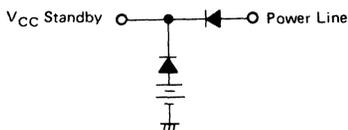


Figure 10 Battery Backup for V_{CC} Standby

• **Reset (\overline{RES})**

This input is used to reset and start the MPU from a power down condition, resulting from a power failure or an initial startup of the processor. On power up, the reset must be held "Low" for at least 100 ms. During operation, RES, when brought "Low", must be held "Low" at least 3 clock cycles.

When a "High" level is detected, the CPU does the following:

- 1) All the higher order address lines will be forced "High".
- 2) I/O Port 2 bits, 2, 1, and 0 are latched into programmed control bits PC2, PC1 and PC0.
- 3) The last two (\$FFFE, \$FFFF) locations in memory will be used to load the program addressed by the program counter.
- 4) The interrupt mask bit is set, must be cleared before the CPU can recognize maskable interrupts.

• **Enable (E)**

This supplies the external clock for the rest of the system when the internal oscillator is used. It is a single phase, TTL compatible clock, and will be the divide by 4 result of the crystal frequency. It will drive one TTL load and 90 pF.

• **Non-Maskable Interrupt (\overline{NMI})**

A low-going edge on this input requests that a non-maskable interrupt sequence be generated within the processor. As with interrupt Request signal, the processor will complete the current instruction that is being executed before it recognizes the NMI signal. The interrupt mask bit in the Condition Code Register has no effect on NMI.

In response to an \overline{NMI} interrupt, the Index Register, Program Counter, Accumulators, and Condition Code Register are stored on the stack. At the end of the sequence, a 16-bit address will be loaded that points to a vectored address located in memory locations \$FFFC and \$FFFD. An address loaded at these locations causes the CPU to branch to a non-maskable interrupt service routine in memory.

A 3.3 kΩ external resistor to V_{CC} should be used for wire-OR and optimum control of interrupts.

Inputs $\overline{IRQ_1}$ and \overline{NMI} are hardware interrupt lines that are sampled during E and will start the interrupt routine on the E following the completion of an instruction.

• **Interrupt Request ($\overline{IRQ_1}$)**

This level sensitive input requests that an interrupt sequence be generated within the machine. The processor will wait until it completes the current instruction that it being executed before it recognizes the request. At that time, if the interrupt mask bit in the Condition Code Register is not set, the machine will begin an interrupt sequence. The Index Register, Program Counter, Accumulators, and Condition Code Register are stored on the stack. Next the CPU will respond to the interrupt request by setting the interrupt mask bit "High" so that no further maskable interrupts may occur. At the end of the cycle, a 16-bit address will be loaded that points to a vectored address which is located in memory locations \$FFF8 and \$FFF9. An address loaded at these locations causes the CPU to branch to an interrupt routine in memory.

The $\overline{IRQ_1}$ requires a 3.3 kΩ external resistor to V_{CC} which should be used for wire-OR and optimum control of interrupts. Internal Interrupts will use an internal interrupt line ($\overline{IRQ_2}$). This interrupt will operate the same as $\overline{IRQ_1}$ except that it will use the vector address of \$FFF0 through \$FFF7. $\overline{IRQ_1}$ will have priority over $\overline{IRQ_2}$ if both occur at the same time. The Interrupt Mask Bit in the condition code register masks both interrupts (See Table 1).

Table 1 Interrupt Vector Location

Vector		Interrupt	
MSB	LSB		
Highest	FFFE	FFFF	\overline{RES}
	FFFC	FFFD	\overline{NMI}
	FFFA	FFFB	Software Interrupt (SWI)
	FFF8	FFF9	$\overline{IRQ_1}$
	FFF6	FFF7	ICF (Input Capture)
	FFF4	FFF5	OCF (Output Compare)
	FFF2	FFF3	TOF (Timer Overflow)
Lowest	FFF0	FFF1	SCI (RDRF + ORFE + TDRE)

• **Read/Write (R/\overline{W})**

This TTL compatible output signals the peripherals and memory devices whether the CPU is in a Read ("High") or a Write ("Low") state. The normal standby state of this signal is Read ("High"). This output is capable of driving one TTL load and 90 pF.

• **Address Strobe (AS)**

In the expanded multiplexed mode of operation address strobe is output on this pin. This signal is used to latch the 8 LSB's of address which are multiplexed with data on Port 3. An 8-bit latch is utilized in conjunction with Address Strobe, as shown in figure 11. Expanded Multiplexed Mode. Address Strobe signals the latch when it is time to latch the address lines so the lines can become data bus lines during the E pulse. The timing for this signal is shown in Figure 1 of Bus Timing. This signal is also used to disable the address from the multiplexed bus allowing a deselect time, t_{ASD} before the data is enabled to the bus.

■ **PORTS**

There are two I/O ports on the HD6803 MPU; one 8-bit port and one 5-bit port. Each port has an associated write

only Data Direction Register which allows each I/O line to be programmed to act as an input or an output*. A "1" in the corresponding Data Direction Register bit will cause that I/O line to be an output. A "0" in the corresponding Data Direction Register bit will cause that I/O line to be an input. There are two ports: Port 1, Port 2. Their addresses and the addresses of their Data Direction registers are given in Table 2.

* The only exception is bit 1 of Port 2, which can either be data input or Timer output.

Table 2 Port and Data Direction Register Addresses

Ports	Port Address	Data Direction Register Address
I/O Port 1	\$0002	\$0000
I/O Port 2	\$0003	\$0001

● I/O Port 1

This is an 8-bit port whose individual bits may be defined as inputs or outputs by the corresponding bit in its data direction register. The 8 output buffers have three-state capability, allowing them to enter a high impedance state when the peripheral data lines are used as inputs. In order to be read properly, the voltage on the input lines must be greater than 2.0 V for a logic "1" and less than 0.8 V for a logic "0". As outputs, these lines are TTL compatible and may also be used as a source of up to 1 mA at 1.5 V to directly drive a Darlington base. After Reset, the I/O lines are configured as inputs.

● I/O Port 2

This port has five lines that may be defined as inputs or outputs by its data direction register. The 5 output buffers have three-state capability, allowing them to enter a high impedance

state when used as an input. In order to be read properly, the voltage on the input lines must be greater than 2.0 V for a logic "1" and less than 0.8 V for a logic "0". As outputs, this port has no internal pullup resistors but will drive TTL inputs directly. For driving CMOS inputs, external pullup resistors are required. After Reset, the I/O lines are configured as inputs. Three pins on Port 2 (pin 8, 9 and 10 of the chip) are requested to set following values (Table 3) during reset. The values of above three pins during reset are latched into the three MSBs (Bit 5, 6 and 7) of Port 2 which are read only.

Port 2 can be configured as I/O and provides access to the Serial Communications Interface and the Timer. Bit 1 is the only pin restricted to data input or Timer output.

Table 3 The Values of three pins

Pin Number	Value
8	L
9	H
10	L

(NOTES) L; Logical "0"
H; Logical "1"

■ BUS

● Data/Address Lines (D₀/A₀ ~ D₇/A₇)

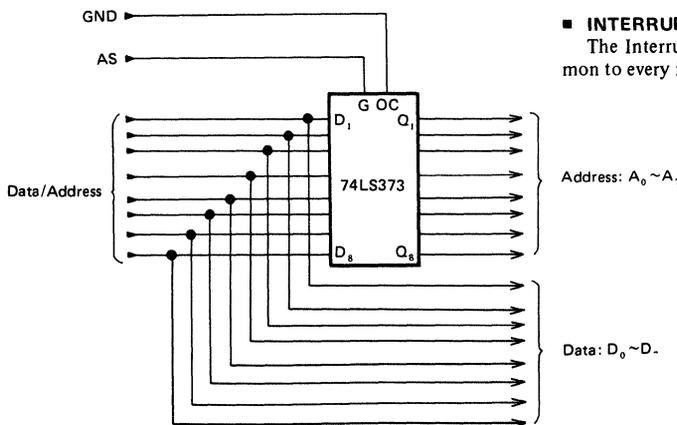
Since the data bus is multiplexed with the lower order address bus in Data/Address, latches are required to latch those address bits. The 74LS373 Transparent Octal D-type latch can be used with the HD6803 to latch the least significant address byte. Figure 11 shows how to connect the latch to the HD6803. The output control to the 74LS373 may be connected to ground.

● Address Lines (A₈ ~ A₁₅)

Each line is TTL compatible and can drive one TTL load and 90 pF. After reset, these pins become output for upper order address lines (A₈ to A₁₅).

■ INTERRUPT FLOWCHART

The Interrupt flowchart is depicted in Figure 16 and is common to every interrupt excluding reset.



Address: A₀ ~ A₇

Data: D₀ ~ D₇

Function Table

Output Control	Enable		Output Q
	G	D	
L	H	H	H
L	H	L	L
L	L	x	Q ₀
H	x	x	Z

Figure 11 Latch Connection

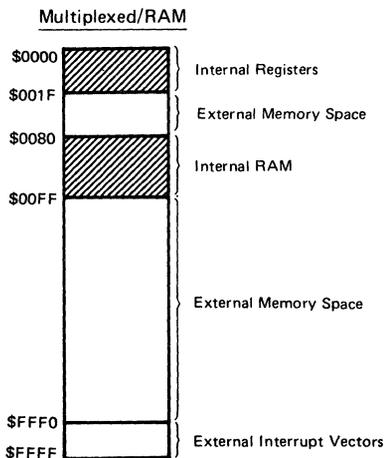
■ MEMORY MAP

The MPU can provide up to 65k byte address space. A memory map is shown in Figure 12. The first 32 locations are reserved for the MPU's internal register area, as shown in Table 4 with exceptions as indicated.

Table 4 Internal Register Area

Register	Address
Port 1 Data Direction Register**	00
Port 2 Data Direction Register**	01
Port 1 Data Register	02
Port 2 Data Register	03
Not Used	04*
Not Used	05*
Not Used	06*
Not Used	07*
Timer Control and Status Register	08
Counter (High Byte)	09
Counter (Low Byte)	0A
Output Compare Register (High Byte)	0B
Output Compare Register (Low Byte)	0C
Input Capture Register (High Byte)	0D
Input Capture Register (Low Byte)	0E
Not Used	0F*
Rate and Mode Control Register	10
Transmit/Receive Control and Status Register	11
Receive Data Register	12
Transmit Data Register	13
RAM Control Register	14
Reserved	15-1F

* External Address
 ** 1; Output, 0; Input



[NOTE]

Excludes the following addresses which may be used externally: \$04, \$05, \$06, \$07, and \$0F.

Figure 12 HD6803 Memory Map

■ PROGRAMMABLE TIMER

The HD6803 contains an on-chip 16-bit programmable timer which may be used to perform measurements on an input waveform while independently generating an output waveform. Pulse widths for both input and output signals may vary from a few microseconds to many seconds. The timer hardware consists of

- an 8-bit control and status register,
- a 16-bit free running counter,
- a 16-bit output compare register, and
- a 16-bit input capture register

A block diagram of the timer registers is shown in Figure 13.

● Free Running Counter (\$0009:000A)

The key element in the programmable timer is a 16-bit free running counter which is driven to increasing values by E (Enable). The counter value may be read by the CPU software at any time. The counter is cleared to zero on RES and may be considered a read-only register with one exception. Any CPU write to the counter's address (\$09) will always result in preset value of \$FFF8 being loaded into the counter regardless of the value involved in the write. This preset figure is intended for testing operation of the part, but may be of value in some applications.

● Output Compare Register (\$000B:000C)

The Output Compare Register is a 16-bit read/write register which is used to control an output waveform. The contents of this register are constantly compared with the current value of the free running counter. When a match is found, a flag is set (OCF) in the Timer Control and Status Register (TCSR) and the current value of the Output Level bit (OLVL) in the TCSR is clocked to the Output Level Register. Providing the Data Direction Register for Port 2, Bit 1 contains a "1" (Output), the output level register value will appear on the pin for Port 2 Bit 1. The values in the Output Compare Register and Output Level bit may then be changed to control the output level on the next compare value. The Output Compare Register is set to \$FFFF during RES. The Compare function is inhibited for one cycle following a write to the high byte of the Output Compare Register to insure a valid 16-bit value is in the register before a compare is made.

● Input Capture Register (\$000D:000E)

The Input Capture Register is a 16-bit read-only register used to store the current value of the free running counter when the proper transition of an external input signal occurs. The input transition change required to trigger the counter transfer is controlled by the input Edge bit (IEDG) in the TCSR. The Data Direction Register bit for Port 2 Bit 0, should* be clear (zero) in order to gate in the external input signal to the edge detect unit in the timer.

* With Port 2 Bit 0 configured as an output and set to "1", the external input will still be seen by the edge detect unit.

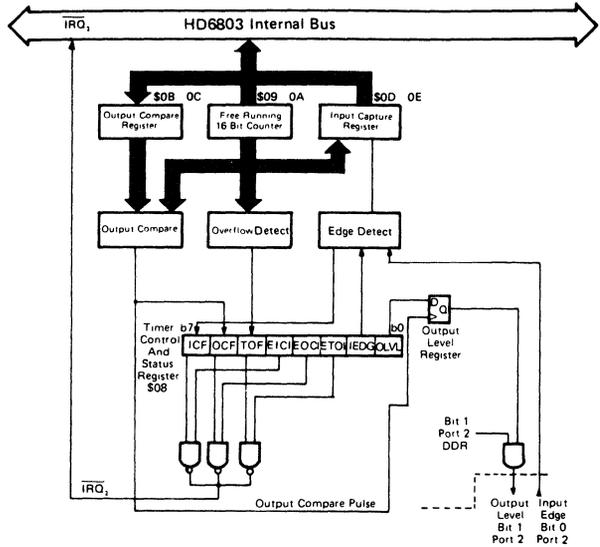
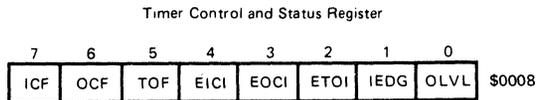


Figure 13 Block Diagram of Programmable Timer



• **Timer Control and Status Register (TCSR) (\$0008)**

The Timer Control and Status Register consists of an 8-bit register of which all 8 bits are readable but only the low order 5 bits may be written. The upper three bits contain read-only timer status information and indicate that:

- a proper transition has taken place on the input pin with a subsequent transfer of the current counter value to the input capture register.
- a match has been found between the value in the free running counter and the output compare register, and when \$0000 is in the free running counter.

Each of the flags may be enabled onto the HD6803 internal bus (\overline{IRQ}_2) with an individual Enable bit in the TCSR. If the 1-bit in the HD6803 Condition Code register has been cleared, a priority vectored interrupt will occur corresponding to the flag bit(s) set. A description for each bit follows:

- Bit 0 OLVL** Output Level – This value is clocked to the output level register on a successful output compare. If the DDR for Port 2 bit 1 is set, the value will appear on the output pin.
- Bit 1 IEDG** Input Edge – This bit controls which transition of an input will trigger a transfer of the counter to the input capture register. The DDR for Port 2 Bit 0 must be clear for this function to operate. IEDG = 0 Transfer takes place on a negative edge (“High”-to-“Low” transition). IEDG = 1 Transfer takes place on a positive edge

(“Low”-to-“High” transition).

- Bit 2 ETOI** Enable Timer Overflow Interrupt – When set, this bit enables \overline{IRQ}_2 to appear on the internal bus for a TOF interrupt; when clear the interrupt is inhibited.
- Bit 3 EOCl** Enable Output Compare Interrupt – When set, this bit enables \overline{IRQ}_2 to appear on the internal bus for an output compare interrupt; when clear the interrupt is inhibited.
- Bit 4 EICI** Enable input Capture Interrupt – When set, this bit enables \overline{IRQ}_2 to occur on the internal bus for an input capture interrupt; when clear the interrupt is inhibited.
- Bit 5 TOF** Timer Overflow Flag – This read-only bit is set when the counter contains \$FFFF. It is cleared by a read of the TCSR (with TOE set) followed by an CPU read of the Counter (\$09).
- Bit 6 OCF** Output Compare Flag – This read-only bit is set when a match is found between the output compare register and the free running counter. It is cleared by a read of the TCSR (with OCF set) followed by an CPU write to the output compare register (\$0B or \$0C).
- Bit 7 ICF** Input Capture Flag – This read-only status bit is set by a proper transition on the input; it is cleared by a read of the TCSR (with ICF set) followed by an CPU read of the Input Capture Register (\$0D).

■ SERIAL COMMUNICATIONS INTERFACE

The HD6803 contains a full-duplex asynchronous serial communications interface (SCI) on chip. The controller comprises a transmitter and a receiver which operate independently or each other but in the same data format and at the same data rate. Both transmitter and receiver communicate with the CPU via the data bus and with the outside world via pins 2, 3, and 4 of Port 2. The hardware, software, and registers are explained in the following paragraphs.

● Wake-Up Feature

In a typical multi-processor application, the software protocol will usually contain a destination address in the initial byte(s) of the message. In order to permit non-selected MPU's to ignore the remainder of the message, a wake-up feature is included whereby all further interrupt processing may be optionally inhibited until the beginning of the next message. When the next message appears, the hardware re-enables (or "wakes-up") for the next message. The "wake-up" is automatically triggered by a string of ten consecutive 1's which indicates an idle transmit line. The software protocol must provide for the short idle period between any two consecutive messages.

● Programmable Options

The following features of the HD6803 serial I/O section are programmable:

- format – standard mark/space (NRZ)
- Clock – external or internal
- baud rate – one of 4 per given CPU ϕ_2 clock frequency or external clock $\times 8$ input
- wake-up feature – enabled or disabled
- Interrupt requests – enabled or masked individually for transmitter and receiver data registers
- clock output – internal clock enabled or disabled to Port 2 (Bit 2)
- Port 2 (bits 3 and 4) – dedicated or not dedicated to serial I/O individually for transmitter and receiver.

● Serial Communications Hardware

The serial communications hardware is controlled by 4 registers as shown in Figure 14. The registers include:

- an 8-bit control and status register
- a 4-bit rate and mode control register (write only)
- an 8-bit read only receive data register and
- an 8-bit write only transmit data register.

In addition to the four registers, the serial I/O section utilizes bit 3 (serial input) and bit 4 (serial output) of Port 2. Bit 2 of Port 2 is utilized if the internal-clock-out or external-clock-in options are selected.

Transmit/Receive Control and Status (TRCS) Register

The TRCS register consists of an 8-bit register of which all 8 bits may be read while only bits 0~4 may be written. The register is initialized to \$20 on RES. The bits in the TRCS register are defined as follows:

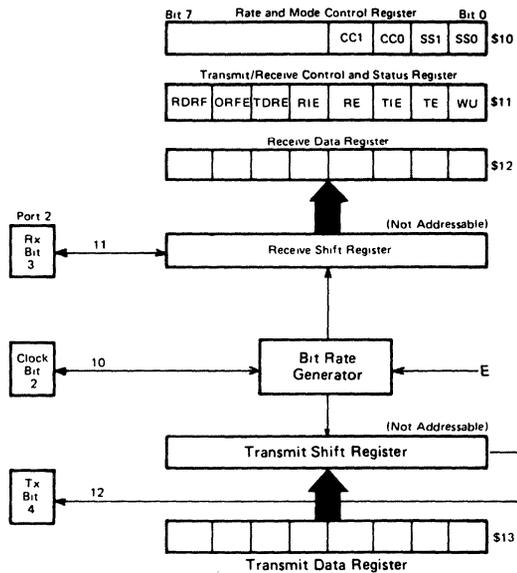
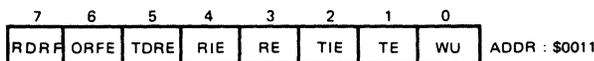


Figure 14 Serial I/O Registers

- Bit 0 WU** "Wake-up" on Next Message – set by HD6803 software and cleared by hardware on receipt of ten consecutive 1's or reset of RE flag. It should be noted that RE flag should be set in advance of CPU set of WU flag.
- Bit 1 TE** Transmit Enable – set by HD6803 to produce preamble of nine consecutive 1's and to enable gating of transmitter output to Port 2, bit 4 regardless of the DDR value corresponding to this bit; when clear, serial I/O has no effect on Port 2 bit 4.
TE set should be after at least one bit time of data transmit rate from the set-up of transmit data rate and mode.
- Bit 2 TIE** Transmit Interrupt Enable – when set, will permit an \overline{IRQ}_2 interrupt to occur when bit 5 (TDRE) is set; when clear, the TDRE value is masked from the bus.
- Bit 3 RE** Receiver Enable – when set, gates Port 2 bit 3 to input of receiver regardless of DDR value for this bit; when clear, serial I/O has no effect on Port 2 bit 3.
- Bit 4 RIE** Receiver Interrupt Enable – when set, will permit an \overline{IRQ}_2 interrupt to occur when bit 7 (RDRF) or bit 6 (ORFE) is set; when clear, the interrupt is masked.

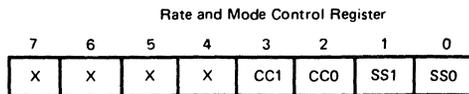
Transmit/Receive Control and Status Register



Bit 5 TDRE Transmit Data Register Empty – set by hardware when a transfer is made from the transmit data register to the output shift register. The TDRE bit is cleared by reading the status register, then

writing a new byte into the transmit data register, TDRE is initialized to 1 by \overline{RES} .

Bit 6 ORFE Over-Run-Framing Error – set by hardware when an overrun or framing error occurs (receive only).



ADDR : \$0010

An overrun is defined as a new byte received with last byte still in Dat Register/Buffer. A framing error has occurred when the byte boundaries in bit stream are not synchronized to bit counter. If WU-flag is set, the ORFE bit will not be set. The ORFE bit is cleared by reading the status register, then reading the Receive Data Register, or by \overline{RES} .

- format
- clocking source, and
- Port 2 bit 2 configuration

The register consists of 4 bits all of which are write-only and cleared on \overline{RES} . The 4 bits in the register may be considered as a pair of 2-bit fields. The two low order bits control the bit rate for internal clocking and the remaining two bits control the format and clock select logic. The register definition is as follows:

Bit 7 RDRF Receiver Data Register Full-set by hardware when a transfer from the input shift register to the receiver data register is made. If WU-flag is set, the RDRF bit will not be set. The RDRF bit is cleared by reading the status register, then reading the Receive Data Register, or by \overline{RES} .

- Bit 0 SS0** Speed Select – These bits select the Baud rate for the internal clock. The four rates which may be selected are a function of the CPU ϕ_2 clock frequency. Table 5 lists the available Baud rates.
- Bit 1 SS1** Speed Select – These bits select the Baud rate for the internal clock. The four rates which may be selected are a function of the CPU ϕ_2 clock frequency. Table 5 lists the available Baud rates.
- Bit 2 CC0** Clock Control and Format Select – this 2-bit field controls the format and clock select logic. Table 6 defines the bit field.
- Bit 3 CC1** Clock Control and Format Select – this 2-bit field controls the format and clock select logic. Table 6 defines the bit field.

Rate and Mode Control Register (RMCR)

The Rate and Mode Control register controls the following serial I/O variables:

- Baud rate

Table 5 SCI Bit Times and Rates

SS1 : SS0	XTAL	2.4576 MHz	4.0 MHz	4.9152 MHz*
	E	614.4 kHz	1.0 MHz	1.2288 MHz
0 0	E ÷ 16	26 μ s/38,400 Baud	16 μ s/62,500 Baud	13.0 μ s/76,800 Baud
0 1	E ÷ 128	208 μ s/4,800 Baud	128 μ s/7812.5 Baud	104.2 μ s/9,600 Baud
1 0	E ÷ 1024	1.67 ms/600 Baud	1.024 ms/976.6 Baud	833.3 μ s/1,200 Baud
1 1	E ÷ 4096	6.67 ms/150 Baud	4.096 ms/244.1 Baud	3.33 ms/300 Baud

* HD6803-1 Only

Table 6 SCI Format and Clock Source Control

CC1: CC0	Format	Clock Source	Port 2 Bit 2	Port 2 Bit 3	Port 2 Bit 4
0 0	—	—	—	**	**
0 1	NRZ	Internal	Not Used	**	**
1 0	NRZ	Internal	Output*	**	**
1 1	NRZ	External	Input	**	**

* Clock output is available regardless of values for bits RE and TE.
 ** Bit 3 is used for serial input if RE = "1" in TRCS; bit 4 is used for serial output if TE = "1" in TRCS.

Internally Generated Clock

If the user wishes for the serial I/O to furnish a clock, the following requirements are applicable:

- the values of RE and TE are immaterial.
- CC1, CC0 must be set to 10
- the maximum clock rate will be E ÷ 16.
- the clock will be at 1x the bit rate and will have a rising edge at mid-bit.

Externally Generated Clock

If the user wishes to provide an external clock for the serial I/O, the following requirements are applicable:

- the CC1, CC0, field in the Rate and Mode Control Register must be set to 11,
- the external clock must be set to 8 times (x8) the desired baud rate and
- the maximum external clock frequency is 1.0 MHz.

● **Serial Operations**

The serial I/O hardware should be initialized by the HD6803 software prior to operation. This sequence will normally consist of;

- writing the desired operation control bits to the Rate and Mode Control Register and
- writing the desired operational control bits in the Transmit/Receive Control and Status Register.

The Transmitter Enable (TE) and Receiver Enable (RE) bits may be left set for dedicated operations.

Transmit Operations

The transmit operation is enabled by the TE bit in the Transmit/Receive Control and Status Register. This bit when set, gates the output of the serial transmit shift register to Port 2. Bit 4 and takes unconditional control over the Data Direction Register value for Port 2, Bit 4.

Following a RES the user should configure both the Rate and Mode Control Register and the Transmit/Receive Control and Status Register for desired operation. Setting the TE bit during this procedure initiates the serial output by first transmitting a nine-bit preamble of 1's. Following the preamble, internal synchronization is established and the transmitter section is ready for operation.

At this point one of two situation exist:

- 1) if the Transmit Data Register is empty (TDRE = 1), a continuous string of ones will be sent indicating an idle line, or,
- 2) if data has been loaded into the Transmit Data Register (TDRE = 0), the word is transferred to the output shift register and transmission of the data word will begin.

During the transfer itself, the 0 start bit is first transmitted. Then the 8 data bits (beginning with bit 0) followed by the stop bit, are transmitted. When the Transmitter Data Register has been emptied, the hardware sets the TDRE flag bit.

If the HD6803 fails to respond to the flag within the proper time, (TDRE is still set when the next normal transfer from the parallel data register to the serial output register should occur) then a 1 will be sent (instead of a 0) at "Start" bit time, followed by more 1's until more data is supplied to the data register. No 0's will be sent while TDRE remains a 1.

Receive Operation

The receive operation is enabled by the RE bit which gates in the serial input through Port 2, Bit 3. The receiver section operation is conditioned by the contents of the Transmit/Receive Control and Status Register and the Rate and Mode Control Register.

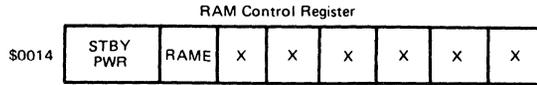
The receiver bit interval is divided into 8 sub-intervals for internal synchronization. In the NRZ Mode, the received bit stream is synchronized by the first 0 (space) encountered.

The approximate center of each bit time is strobed during the next 10 bits. If the tenth bit is not a 1 (stop bit) a framing error is assumed, and bit ORFE is set. If the tenth bit as a 1, the data is transferred to the Receive Data Register, and interrupt flag RDRF is set. If RDRF is still set at the next tenth bit time, ORFE will be set, indicating an overrun has occurred. When the HD6803 responds to either flag (RDRF or ORFE) by reading the status register followed by reading the Data Register, RDRF (or ORFE) will be cleared.

■ **RAM CONTROL REGISTER**

This register, which is addressed at \$0014, gives status information about the standby RAM. A 0 in the RAM enable bit (RAM E) will disable the standby RAM, thereby protecting

it at power down if V_{CC} Standby is held greater than V_{SBB} volts, as explained previously in the signal description for V_{CC} Standby.



- Bit 0 Not used.
- Bit 1 Not used.
- Bit 2 Not used.
- Bit 3 Not used.
- Bit 4 Not used.
- Bit 5 Not used.

Bit 6 RAME The RAM Enable control bit allows the user the ability to disable the standby RAM. This bit is set to a logic "1" by RES which enables the standby RAM and can be written to one or zero under program control. When the RAM is disabled, data is read from external memory.

Bit 7 STBY PWR The Standby Power bit is cleared when the standby voltage is removed. This bit is a read/write status flag that the user can read which indicates that the standby RAM voltage has been applied, and the data in the standby RAM is valid.

■ **GENERAL DESCRIPTION OF INSTRUCTION SET**

The HD6803 is upward object code compatible with the HD6800 as it implements the full HMCS6800 instruction set. The execution times of key instructions have been reduced to increase throughput. In addition, new instructions have been added; these include 16-bit operations and a hardware multiply.

Included in the instruction set section are the following:

- CPU Programming Model (Figure 15)
- Addressing modes
- Accumulator and memory instructions – Table 7
- New instructions
- Index register and stack manipulations instructions – Table 8
- Jump and branch instructions – Table 9
- Condition code register manipulation instructions – Table 10
- Instructions Execution times in machine cycles – Table 11
- Summary of cycle by cycle operation – Table 12
- Summary of undefined instructions – Table 13

● **CPU Programming Model**

The programming model for the HD6803 is shown in Figure 15. The double (D) accumulator is physically the same as the Accumulator A concatenated with the Accumulator B so that any operation using accumulator D will destroy information in A and B.

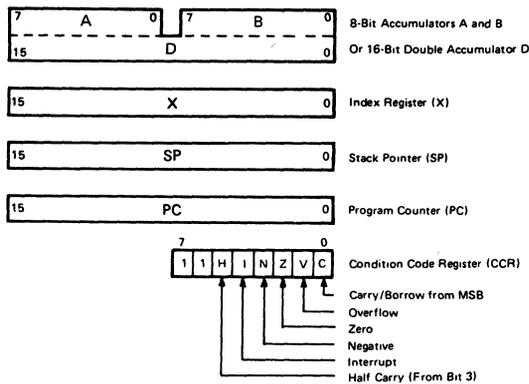


Figure 15 CPU Programming Model

● CPU Addressing Modes

The HD6803 8-bit microcomputer unit has seven address modes that can be used by a programmer, with the addressing mode a function of both the type of instruction and the coding within the instruction. A summary of the addressing modes for a particular instruction can be found in Table 11 along with the associated instruction execution time that is given in machine cycles. With a clock frequency of 4 MHz, these times would be microseconds.

Accumulator (ACCX) Addressing

In accumulator only addressing, either accumulator A or accumulator B is specified. These are one-byte instructions.

Immediate Addressing

In immediate addressing, the operand is contained in the second byte of the instruction except LDS and LDX which have the operand in the second and third bytes of the instruction. The CPU addresses this location when it fetches the immediate instruction for execution. These are two or three-byte instructions.

Table 7 Accumulator & Memory Instructions

Operations	Mnemonic	Addressing Modes												Boolean/ Arithmetic Operation	Condition Code Register									
		IMMED.			DIRECT			INDEX			EXTEND				IMPLIED			5	4	3	2	1	0	
		OP	~	#	OP	~	#	OP	~	#	OP	~	#		OP	~	#	H	I	N	Z	V	C	
Add	ADDA	8B	2	2	9B	3	2	AB	4	2	BB	4	3			A + M → A	↑	•	↑	↑	↑	↑		
	ADDB	CB	2	2	DB	3	2	EB	4	2	FB	4	3			B + M → B	↑	•	↑	↑	↑	↑		
Add Double	ADDD	C3	4	3	D3	5	2	E3	6	2	F3	6	3			A : B + M : M + 1 → A · B	•	•	↑	↑	↑	↑		
Add Accumulators	ABA													1B	2	1	A + B → A	↑	•	↑	↑	↑	↑	
Add With Carry	ADCA	89	2	2	99	3	2	A9	4	2	B9	4	3			A + M + C → A	↑	•	↑	↑	↑	↑		
	ADCB	C9	2	2	D9	3	2	E9	4	2	F9	4	3			B + M + C → B	↑	•	↑	↑	↑	↑		
AND	ANDA	84	2	2	94	3	2	A4	4	2	B4	4	3			A · M → A	•	•	↑	↑	R	•		
	ANDB	C4	2	2	D4	3	2	E4	4	2	F4	4	3			B · M → B	•	•	↑	↑	R	•		
Bit Test	BIT A	85	2	2	95	3	2	A5	4	2	B5	4	3			A · M	•	•	↑	↑	R	•		
	BIT B	C5	2	2	D5	3	2	E5	4	2	F5	4	3			B · M	•	•	↑	↑	R	•		
Clear	CLR							6F	6	2	7F	6	3			00 → M	•	•	R	S	R	•		
	CLRA													4F	2	1	00 → A	•	•	R	S	R	R	
	CLRB													5F	2	1	00 → B	•	•	R	S	R	R	
Compare	CMPA	81	2	2	91	3	2	A1	4	2	B1	4	3			A - M	•	•	↑	↑	↑	↑		
	CMPB	C1	2	2	D1	3	2	E1	4	2	F1	4	3			B - M	•	•	↑	↑	↑	↑		
Compare Accumulators	CBA													11	2	1	A - B	•	•	↑	↑	↑	↑	
Complement, 1's	COM							63	6	2	73	6	3			M → M	•	•	↑	↑	R	S		
	COMA													43	2	1	A → A	•	•	↑	↑	R	S	
	COMB													53	2	1	B → B	•	•	↑	↑	R	S	
Complement, 2's (Negate)	NEG							60	6	2	70	6	3			00 - M - M	•	•	↑	↑	↑	2		
	NEGA													40	2	1	00 - A → A	•	•	↑	↑	↑	2	
	NEGB													50	2	1	00 - B → B	•	•	↑	↑	↑	2	
Decimal Adjust, A	DAA													19	2	1	Converts binary add of BCD characters into BCD format	•	•	↑	↑	↑	3	
Decrement	DEC							6A	6	2	7A	6	3			M - 1 → M	•	•	↑	↑	↑	4	•	
	DECA													4A	2	1	A - 1 → A	•	•	↑	↑	↑	4	•
	DECB													5A	2	1	B - 1 → B	•	•	↑	↑	↑	4	•
Exclusive OR	EORA	88	2	2	98	3	2	A8	4	2	B8	4	3			A ⊕ M → A	•	•	↑	↑	R	•		
	EORB	C8	2	2	D8	3	2	E8	4	2	F8	4	3			B ⊕ M → B	•	•	↑	↑	R	•		
Increment	INC							6C	6	2	7C	6	3			M + 1 → M	•	•	↑	↑	↑	5	•	
	INCA													4C	2	1	A + 1 → A	•	•	↑	↑	↑	5	•
	INCB													5C	2	1	B + 1 → B	•	•	↑	↑	↑	5	•
Load Accumulator	LDAA	86	2	2	96	3	2	A6	4	2	B6	4	3			M → A	•	•	↑	↑	R	•		
	LDAB	C6	2	2	D6	3	2	E6	4	2	F6	4	3			M → B	•	•	↑	↑	R	•		
Load Double Accumulator	LDD	CC	3	3	DC	4	2	EC	5	2	FC	5	3			M + 1 → B, M → A	•	•	↑	↑	R	•		
Multiply Unsigned	MUL													3D	10	1	A × B → A : B	•	•	•	•	•	11	
OR, Inclusive	ORAA	8A	2	2	9A	3	2	AA	4	2	BA	4	3			A + M → A	•	•	↑	↑	R	•		
	ORAB	CA	2	2	DA	3	2	EA	4	2	FA	4	3			B + M → B	•	•	↑	↑	R	•		
Push Data	PSHA													36	3	1	A → Msp, SP - 1 → SP	•	•	•	•	•	•	
	PSHB													37	3	1	B → Msp, SP - 1 → SP	•	•	•	•	•	•	
Pull Data	PULA													32	4	1	SP + 1 → SP, Msp → A	•	•	•	•	•	•	
	PULB													33	4	1	SP + 1 → SP, Msp → B	•	•	•	•	•	•	
Rotate Left	ROL							69	6	2	79	6	3			M	•	•	↑	↑	6	↑		
	ROLA													49	2	1	A	•	•	↑	↑	6	↑	
	ROLB													59	2	1	B	•	•	↑	↑	6	↑	
Rotate Right	ROR							66	6	2	76	6	3			M	•	•	↑	↑	6	↑		
	RORA													46	2	1	A	•	•	↑	↑	6	↑	
	RORB													56	2	1	B	•	•	↑	↑	6	↑	

The Condition Code Register notes are listed after Table 10.

(Continued)

● New Instructions

In addition to the existing 6800 Instruction Set, the following new instructions are incorporated in the HD6803 Microcomputer.

- ABX** Adds the 8-bit unsigned accumulator B to the 16-bit X-Register taking into account the possible carry out of the low order byte of the X-Register.
- ADD** Adds the double precision ACCD* to the double precision value M:M+1 and places the results in ACCD.
- ASLD** Shifts all bits of ACCD one place to the left. Bit 0 is loaded with zero. The C bit is loaded from the most significant bit of ACCD.
- LDD** Loads the contents of double precision memory location into the double accumulator A:B. The condition codes are set according to the data.
- LSRD** Shifts all bits of ACCD one place to the right. Bit 15 is loaded with zero. The C bit is loaded from the least significant bit to ACCD.
- MUL** Multiplies the 8 bits in accumulator A with the 8 bits in accumulator B to obtain a 16-bit unsigned number in A:B, ACCA contains MSB of result.
- PSHX** The contents of the index register is pushed onto the stack at the address contained in the stack pointer. The stack pointer is decremented by 2.
- PULX** The index register is pulled from the stack beginning at the current address contained in the stack pointer +1. The stack pointer is incremented by 2 in total.
- STD** Stores the contents of double accumulator A:B in memory. The contents of ACCD remain unchanged.
- SUBD** Subtracts the contents of M:M + 1 from the contents of double accumulator AB and places the result in ACCD.
- BRN** Never branches. If effect, this instruction can be considered a two byte NOP (No operation) requiring three cycles for execution.
- CPX** Internal processing modified to permit its use with any conditional branch instruction.

*ACCD' is the 16 bit register (A:B) formed by concatenating the A and B accumulators. The A-accumulator is the most significant byte.

Table 8 Index Register and Stack Manipulation Instructions

Pointer Operations	Mnemonic	Addressing Modes										Boolean/ Arithmetic Operation	Condition Code Register										
		IMMED.		DIRECT		INDEX		EXTND		IMPLIED			5	4	3	2	1	0					
		OP	~ #	OP	~ #	OP	~ #	OP	~ #	OP	~ #		H	N	Z	V	C						
Compare Index Reg	CPX	8C	4 3	9C	5 2	AC	6 2	BC	6 3								X - M . M + 1	•	•	!	!	!	!
Decrement Index Reg	DEX										09	3 1					X - 1 → X	•	•	•	!	•	•
Decrement Stack Pntr	DES										34	3 1					SP - 1 → SP	•	•	•	•	•	•
Increment Index Reg	INX										08	3 1					X + 1 → X	•	•	•	!	•	•
Increment Stack Pntr	INS										31	3 1					SP + 1 → SP	•	•	•	•	•	•
Load Index Reg	LDX	CE	3 3	DE	4 2	EE	5 2	FE	5 3								M → X _H , (M + 1) → X _L	•	•	?	!	R	•
Load Stack Pntr	LDS	8E	3 3	9E	4 2	AE	5 2	BE	5 3								M → SP _H , (M + 1) → SP _L	•	•	?	!	R	•
Store Index Reg	STX			DF	4 2	EF	5 2	FF	5 3								X _H → M, X _L → (M + 1)	•	•	?	!	R	•
Store Stack Pntr	STS			9F	4 2	AF	5 2	BF	5 3								SP _H → M, SP _L → (M + 1)	•	•	?	!	R	•
Index Reg → Stack Pntr	TXS										35	3 1					X - 1 → SP	•	•	•	•	•	•
Stack Pntr → Index Reg	TSX										30	3 1					SP + 1 → X	•	•	•	•	•	•
Add	ABX										3A	3 1					B + X → X	•	•	•	•	•	•
Push Data	PSHX										3C	4 1					X _L → M _{sp} , SP - 1 → SP X _H → M _{sp} , SP - 1 → SP	•	•	•	•	•	•
Pull Data	PULX										38	5 1					SP + 1 → SP, M _{sp} → X _H SP + 1 → SP, M _{sp} → X _L	•	•	•	•	•	•

The Condition Code Register notes are listed after Table 10.

Table 9 Jump and Branch Instructions

Operations	Mnemonic	Addressing Modes												Branch Test	Condition Code Register								
		RELATIVE			DIRECT			INDEX			EXTND				IMPLIED			5	4	3	2	1	0
		OP	~	#	OP	~	#	OP	~	#	OP	~	#		OP	~	#	H	I	N	Z	V	C
Branch Always	BRA	20	3	2																			
Branch Never	BRN	21	3	2																			
Branch If Carry Clear	BCC	24	3	2																			
Branch If Carry Set	BCS	25	3	2																			
Branch If = Zero	BEQ	27	3	2																			
Branch If ≥ Zero	BGE	2C	3	2																			
Branch If > Zero	BGT	2E	3	2																			
Branch If Higher	BHI	22	3	2																			
Branch If ≤ Zero	BLE	2F	3	2																			
Branch If Lower Or Same	BLS	23	3	2																			
Branch If < Zero	BLT	2D	3	2																			
Branch If Minus	BMI	2B	3	2																			
Branch If Not Equal Zero	BNE	26	3	2																			
Branch If Overflow Clear	BVC	28	3	2																			
Branch If Overflow Set	BVS	29	3	2																			
Branch If Plus	BPL	2A	3	2																			
Branch To Subroutine	BSR	8D	6	2																			
Jump	JMP							6E	3	2		7E	3	3									
Jump To Subroutine	JSR				9D	5	2	AD	6	2		BD	6	3									
No Operation	NOP														01	2	1						
Return From Interrupt	RTI														3B	10	1						
Return From Subroutine	RTS														39	5	1						
Software Interrupt	SWI														3F	12	1						
Wait for Interrupt	WAI														3E	9	1						

Table 10 Condition Code Register Manipulation Instructions

Operations	Mnemonic	Addressing Modes			Boolean Operation	Condition Code Register					
		IMPLIED				5	4	3	2	1	0
		OP	~	#		H	I	N	Z	V	C
Clear Carry	CLC	0C	2	1	0 → C	•	•	•	•	•	R
Clear Interrupt Mask	CLI	0E	2	1	0 → I	•	R	•	•	•	•
Clear Overflow	CLV	0A	2	1	0 → V	•	•	•	•	R	•
Set Carry	SEC	0D	2	1	1 → C	•	•	•	•	•	S
Set Interrupt Mask	SEI	0F	2	1	1 → I	•	S	•	•	•	•
Set Overflow	SEV	0B	2	1	1 → V	•	•	•	•	S	•
Accumulator A → CCR	TAP	06	2	1	A → CCR	⑩					
CCR → Accumulator A	TPA	07	2	1	CCR → A	•	•	•	•	•	•

Condition Code Register Notes: (Bit set if test is true and cleared otherwise)

- ① (Bit V) Test: Result = 10000000?
- ② (Bit C) Test: Result ≠ 00000000?
- ③ (Bit C) Test: Decimal value of most significant BCD Character greater than nine? (Not cleared if previously set)
- ④ (Bit V) Test: Operand = 10000000 prior to execution?
- ⑤ (Bit V) Test: Operand = 01111111 prior to execution?
- ⑥ (Bit V) Test: Set equal to result of N ⊕ C after shift has occurred.
- ⑦ (Bit N) Test: Result less than zero? (Bit 15 = 1)
- ⑧ (All) Load Condition Code Register from Stack. (See Special Operations)
- ⑨ (Bit I) Set when interrupt occurs. If previously set, a Non-Maskable Interrupt is required to exit the wait state.
- ⑩ (All) Set according to the contents of Accumulator A.
- ⑪ (Bit C) Set equal to result of Bit 7 (AccB)

Table 11 Instruction Execution Times in Machine Cycle

	ACCX	Imme- diate	Direct	Ex- tended	In- dexed	Im- plied	Re- lative		ACCX	Imme- diate	Direct	Ex- tended	In- dexed	Im- plied	Re- lative
ABA	•	•	•	•	•	2	•	INX	•	•	•	•	•	3	•
ABX	•	•	•	•	•	3	•	JMP	•	•	•	3	3	•	•
ADC	•	2	3	4	4	•	•	JSR	•	•	5	6	6	•	•
ADD	•	2	3	4	4	•	•	LDA	•	2	3	4	4	•	•
ADDD	•	4	5	6	6	•	•	LDD	•	3	4	5	5	•	•
AND	•	2	3	4	4	•	•	LDS	•	3	4	5	5	•	•
ASL	2	•	•	6	6	•	•	LDX	•	3	4	5	5	•	•
ASLD	•	•	•	•	•	3	•	LSR	2	•	•	6	6	•	•
ASR	2	•	•	6	6	•	•	LSRD	•	•	•	•	•	3	•
BCC	•	•	•	•	•	•	3	MUL	•	•	•	•	•	10	•
BCS	•	•	•	•	•	•	3	NEG	2	•	•	6	6	•	•
BEQ	•	•	•	•	•	•	3	NOP	•	•	•	•	•	2	•
BGE	•	•	•	•	•	•	3	ORA	•	2	3	4	4	•	•
BGT	•	•	•	•	•	•	3	PSH	3	•	•	•	•	•	•
BHI	•	•	•	•	•	•	3	PSHX	•	•	•	•	•	4	•
BIT	•	2	3	4	4	•	•	PUL	4	•	•	•	•	•	•
BLE	•	•	•	•	•	•	3	PULX	•	•	•	•	•	5	•
BLS	•	•	•	•	•	•	3	ROL	2	•	•	6	6	•	•
BLT	•	•	•	•	•	•	3	ROR	2	•	•	6	6	•	•
BMI	•	•	•	•	•	•	3	RTI	•	•	•	•	•	10	•
BNE	•	•	•	•	•	•	3	RTS	•	•	•	•	•	5	•
BPL	•	•	•	•	•	•	3	SBA	•	•	•	•	•	2	•
BRA	•	•	•	•	•	•	3	SBC	•	2	3	4	4	•	•
BRN	•	•	•	•	•	•	3	SEC	•	•	•	•	•	2	•
BSR	•	•	•	•	•	•	6	SEI	•	•	•	•	•	2	•
BVC	•	•	•	•	•	•	3	SEV	•	•	•	•	•	2	•
BVS	•	•	•	•	•	•	3	STA	•	•	3	4	4	•	•
CBA	•	•	•	•	•	2	•	STD	•	•	4	5	5	•	•
CLC	•	•	•	•	•	2	•	STS	•	•	4	5	5	•	•
CLI	•	•	•	•	•	2	•	STX	•	•	4	5	5	•	•
CLR	2	•	•	6	6	•	•	SUB	•	2	3	4	4	•	•
CLV	•	•	•	•	•	2	•	SUBD	•	4	5	6	6	•	•
CMP	•	2	3	4	4	•	•	SWI	•	•	•	•	•	12	•
COM	2	•	•	6	6	•	•	TAB	•	•	•	•	•	2	•
CPX	•	4	5	6	6	•	•	TAP	•	•	•	•	•	2	•
DAA	•	•	•	•	•	2	•	TBA	•	•	•	•	•	2	•
DEC	2	•	•	6	6	•	•	TPA	•	•	•	•	•	2	•
DES	•	•	•	•	•	3	•	TST	2	•	•	6	6	•	•
DEX	•	•	•	•	•	3	•	TSX	•	•	•	•	•	3	•
EOR	•	2	3	4	4	•	•	TXS	•	•	•	•	•	3	•
INC	2	•	•	6	6	•	•	WAI	•	•	•	•	•	9	•
INS	•	•	•	•	•	3	•								

● **Summary of Cycle by Cycle Operation**

Table 12 provides a detailed description of the information present on the Address Bus, Data Bus, and the Read/Write line (R/W) during each cycle for each instruction.

This information is useful in comparing actual with expected results during debug of both software and hardware as the

control program is executed. The information is categorized in groups according to addressing mode and number of cycles per instruction. (In general, instructions with the same addressing mode and number of cycles execute in the same manner: exceptions are indicated in the table).

Table 12 Cycle by Cycle Operation

Address Mode & Instructions	Cycles	Cycle #	Address Bus	R/W Line	Data Bus	
IMMEDIATE						
ADC EOR	2	1	Op Code Address	1	Op Code	
ADD LDA		2	Op Code Address + 1	1	Operand Data	
AND ORA						
BIT SBC						
CMP SUB						
LDS	3	1	Op Code Address	1	Op Code	
LDX		2	Op Code Address + 1	1	Operand Data (High Order Byte)	
LDD		3	Op Code Address + 2	1	Operand Data (Low Order Byte)	
CPX	4	1	Op Code Address	1	Op Code	
SUBD		2	Op Code Address + 1	1	Operand Data (High Order Byte)	
ADDD		3	Op Code Address + 2	1	Operand Data (Low Order Byte)	
		4	Address Bus FFFF	1	Low Byte of Restart Vector	
DIRECT						
ADC EOR	3	1	Op Code Address	1	Op Code	
ADD LDA		2	Op Code Address + 1	1	Address of Operand	
AND ORA		3	Address of Operand	1	Operand Data	
BIT SBC						
CMP SUB						
STA	3	1	Op Code Address	1	Op Code	
		2	Op Code Address + 1	1	Destination Address	
		3	Destination Address	0	Data from Accumulator	
LDS	4	1	Op Code Address	1	Op Code	
LDX		2	Op Code Address + 1	1	Address of Operand	
LDD		3	Address of Operand	1	Operand Data (High Order Byte)	
		4	Operand Address + 1	1	Operand Data (Low Order Byte)	
STS	4	1	Op Code Address	1	Op Code	
STX		2	Op Code Address + 1	1	Address of Operand	
STD		3	Address of Operand	0	Register Data (High Order Byte)	
		4	Address of Operand + 1	0	Register Data (Low Order Byte)	
CPX	5	1	Op Code Address	1	Op Code	
SUBD		2	Op Code Address + 1	1	Address of Operand	
ADDD		3	Operand Address	1	Operand Data (High Order Byte)	
		4	Operand Address + 1	1	Operand Data (Low Order Byte)	
		5	Address Bus FFFF	1	Low Byte of Restart Vector	
JSR	5	1	Op Code Address	1	Op Code	
		2	Op Code Address + 1	1	Irrelevant Data	
		3	Subroutine Address	1	First Subroutine Op Code	
		4	Stack Pointer	0	Return Address (Low Order Byte)	
		5	Stack Pointer + 1	0	Return Address (High Order Byte)	

(Continued)

Table 12 Cycle by Cycle Operation (Continued)

Address Mode & Instructions	Cycles	Cycle #	Address Bus	R/W Line	Data Bus
INDEXED					
JMP	3	1	Op Code Address	1	Op Code
		2	Op Code Address + 1	1	Offset
		3	Address Bus FFFF	1	Low Byte of Restart Vector
ADC EOR ADD LDA AND ORA BIT SBC CMP SUB	4	1	Op Code Address	1	Op Code
		2	Op Code Address + 1	1	Offset
		3	Address Bus FFFF	1	Low Byte of Restart Vector
		4	Index Register Plus Offset	1	Operand Data
STA	4	1	Op Code Address	1	Op Code
		2	Op Code Address + 1	1	Offset
		3	Address Bus FFFF	1	Low Byte of Restart Vector
		4	Index Register Plus Offset	0	Operand Data
LDS LDX LDD LDD	5	1	Op Code Address	1	Op Code
		2	Op Code Address + 1	1	Offset
		3	Address Bus FFFF	1	Low Byte of Restart Vector
		4	Index Register Plus Offset	1	Operand Data (High Order Byte)
		5	Index Register Plus Offset + 1	1	Operand Data (Low Order Byte)
STS STX STD	5	1	Op Code Address	1	Op Code
		2	Op Code Address + 1	1	Offset
		3	Address Bus FFFF	1	Low Byte of Restart Vector
		4	Index Register Plus Offset	0	Operand Data (High Order Byte)
		5	Index Register Plus Offset + 1	0	Operand Data (Low Order Byte)
ASL LSR ASR NEG CLR ROL COM ROR DEC TST* INC	6	1	Op Code Address	1	Op Code
		2	Op Code Address + 1	1	Offset
		3	Address Bus FFFF	1	Low Byte of Restart Vector
		4	Index Register Plus Offset	1	Current Operand Data
		5	Address Bus FFFF	1	Low Byte of Restart Vector
		6	Index Register Plus Offset	0	New Operand Data
CPX SUBD ADDD	6	1	Op Code Address	1	Op Code
		2	Op Code Address + 1	1	Offset
		3	Address Bus FFFF	1	Low Byte of Restart Vector
		4	Index Register + Offset	1	Operand Data (High Order Byte)
		5	Index Register + Offset + 1	1	Operand Data (Low Order Byte)
		6	Address Bus FFFF	1	Low Byte of Restart Vector
JSR	6	1	Op Code Address	1	Op Code
		2	Op Code Address + 1	1	Offset
		3	Address Bus FFFF	1	Low Byte of Restart Vector
		4	Index Register + Offset	1	First Subroutine Op Code
		5	Stack Pointer	0	Return Address (Low Order Byte)
		6	Stack Pointer - 1	0	Return Address (High Order Byte)

* In the TST instruction, R/W line of the sixth cycle is "1" level, and AB = FFFF, DB = Low Byte of Reset Vector.

(Continued)

Table 12 Cycle by Cycle Operation (Continued)

Address Mode & Instructions	Cycles	Cycle #	Address Bus	R/W Line	Data Bus
EXTENDED					
JMP	3	1	Op Code Address	1	Op Code
		2	Op Code Address + 1	1	Jump Address (High Order Byte)
		3	Op Code Address + 2	1	Jump Address (Low Order Byte)
ADC EOR ADD LDA AND ORA BIT SBC CMP SUB	4	1	Op Code Address	1	Op Code
		2	Op Code Address + 1	1	Address of Operand (High Order Byte)
		3	Op Code Address + 2	1	Address of Operand (Low Order Byte)
		4	Address of Operand	1	Operand Data
STA	4	1	Op Code Address	1	Op Code
		2	Op Code Address + 1	1	Destination Address (High Order Byte)
		3	Op Code Address + 2	1	Destination Address (Low Order Byte)
		4	Operand Destination Address	0	Data from Accumulator
LDS LDX LDD	5	1	Op Code Address	1	Op Code
		2	Op Code Address + 1	1	Address of Operand (High Order Byte)
		3	Op Code Address + 2	1	Address of Operand (Low Order Byte)
		4	Address of Operand	1	Operand Data (High Order Byte)
		5	Address of Operand + 1	1	Operand Data (Low Order Byte)
STS STX STD	5	1	Op Code Address	1	Op Code
		2	Op Code Address + 1	1	Address of Operand (High Order Byte)
		3	Op Code Address + 2	1	Address of Operand (Low Order Byte)
		4	Address of Operand	0	Operand Data (High Order Byte)
		5	Address of Operand + 1	0	Operand Data (Low Order Byte)
ASL LSR ASR NEG CLR ROL COM ROR DEC TST* INC	6	1	Op Code Address	1	Op Code
		2	Op Code Address + 1	1	Address of Operand (High Order Byte)
		3	Op Code Address + 2	1	Address of Operand (Low Order Byte)
		4	Address of Operand	1	Current Operand Data
		5	Address Bus FFFF	1	Low Byte of Restart Vector
		6	Address of Operand	0	New Operand Data
CPX SUBD ADDD	6	1	Op Code Address	1	Op Code
		2	Op Code Address + 1	1	Operand Address (High Order Byte)
		3	Op Code Address + 2	1	Operand Address (Low Order Byte)
		4	Operand Address	1	Operand Data (High Order Byte)
		5	Operand Address + 1	1	Operand Data (Low Order Byte)
		6	Address Bus FFFF	1	Low Byte of Restart Vector
JSR	6	1	Op Code Address	1	Op Code
		2	Op Code Address + 1	1	Address of Subroutine (High Order Byte)
		3	Op Code Address + 2	1	Address of Subroutine (Low Order Byte)
		4	Subroutine Starting Address	1	Op Code of Next Instruction
		5	Stack Pointer	0	Return Address (Low Order Byte)
		6	Stack Pointer - 1	0	Return Address (High Order Byte)

* In the TST instruction, R/W line of the sixth cycle is "1" level, and AB = FFFF, DB = Low Byte of Reset Vector.

(Continued)

Table 12 Cycle by Cycle Operation (Continued)

Address Mode & Instructions	Cycles	Cycle #	Address Bus	R/W Line	Data Bus
IMPLIED					
ABA DAA SEC	2	1	Op Code Address	1	Op Code
ASL DEC SEI		2	Op Code Address + 1	1	Op Code of Next Instruction
ASR INC SEV	3	1	Op Code Address	1	Op Code
CBA LSR TAB					
CLC NEG TAP					
CLI NOP TBA					
CLR ROL TPA					
CLV ROR TST					
COM SBA	3	2	Op Code Address + 1	1	Irrelevant Data
ABX		3	Address Bus FFFF	1	Low Byte of Restart Vector
ASLD		3	1	Op Code Address	1
LSRD	2		Op Code Address + 1	1	Irrelevant Data
	3		Address Bus FFFF	1	Low Byte of Restart Vector
DES	3	1	Op Code Address	1	Op Code
INS		2	Op Code Address + 1	1	Op Code of Next Instruction
		3	Previous Register Contents	1	Irrelevant Data
INX	3	1	Op Code Address	1	Op Code
DEX		2	Op Code Address + 1	1	Op Code of Next Instruction
		3	Address Bus FFFF	1	Low Byte of Restart Vector
PSHA	3	1	Op Code Address	1	Op Code
PSHB		2	Op Code Address + 1	1	Op Code of Next Instruction
		3	Stack Pointer	0	Accumulator Data
TSX	3	1	Op Code Address	1	Op Code
		2	Op Code Address + 1	1	Op Code of Next Instruction
		3	Stack Pointer	1	Irrelevant Data
TXS	3	1	Op Code Address	1	Op Code
		2	Op Code Address + 1	1	Op Code of Next Instruction
		3	Address Bus FFFF	1	Low Byte of Restart Vector
PULA	4	1	Op Code Address	1	Op Code
PULB		2	Op Code Address + 1	1	Op Code of Next Instruction
		3	Stack Pointer	1	Irrelevant Data
		4	Stack Pointer + 1	1	
PSHX	4	1	Op Code Address	1	Op Code
		2	Op Code Address + 1	1	Irrelevant Data
		3	Stack Pointer	0	Index Register (Low Order Byte)
		4	Stack Pointer - 1	0	Index Register (High Order Byte)
PULX	5	1	Op Code Address	1	Op Code
		2	Op Code Address + 1	1	Irrelevant Data
		3	Stack Pointer	1	Irrelevant Data
		4	Stack Pointer + 1	1	Index Register (High Order Byte)
		5	Stack Pointer + 2	1	Index Register (Low Order Byte)
RTS	5	1	Op Code Address	1	Op Code
		2	Op Code Address + 1	1	Irrelevant Data
		3	Stack Pointer	1	Irrelevant Data
		4	Stack Pointer + 1	1	Address of Next Instruction (High Order Byte)
		5	Stack Pointer + 2	1	Address of Next Instruction (Low Order Byte)
WAI**	9	1	Op Code Address	1	Op Code
		2	Op Code Address + 1	1	Op Code of Next Instruction
		3	Stack Pointer	0	Return Address (Low Order Byte)
		4	Stack Pointer - 1	0	Return Address (High Order Byte)

(Continued)

Table 12 Cycle by Cycle Operation (Continued)

Address Mode & Instructions	Cycles	Cycle #	Address Bus	R/ \bar{W} Line	Data Bus
WAI**		5	Stack Pointer - 2	0	Index Register (Low Order Byte)
		6	Stack Pointer - 3	0	Index Register (High Order Byte)
		7	Stack Pointer - 4	0	Contents of Accumulator A
		8	Stack Pointer - 5	0	Contents of Accumulator B
		9	Stack Pointer - 6	0	Contents of Cond. Code Register
MUL	10	1	Op Code Address	1	Op Code
		2	Op Code Address + 1	1	Irrelevant Data
		3	Address Bus FFFF	1	Low Byte of Restart Vector
		4	Address Bus FFFF	1	Low Byte of Restart Vector
		5	Address Bus FFFF	1	Low Byte of Restart Vector
		6	Address Bus FFFF	1	Low Byte of Restart Vector
		7	Address Bus FFFF	1	Low Byte of Restart Vector
		8	Address Bus FFFF	1	Low Byte of Restart Vector
		9	Address Bus FFFF	1	Low Byte of Restart Vector
		10	Address Bus FFFF	1	Low Byte of Restart Vector
RTI	10	1	Op Code Address	1	Op Code
		2	Op Code Address + 1	1	Irrelevant Data
		3	Stack Pointer	1	Irrelevant Data
		4	Stack Pointer + 1	1	Contents of Cond. Code Reg. from Stack
		5	Stack Pointer + 2	1	Contents of Accumulator B from Stack
		6	Stack Pointer + 3	1	Contents of Accumulator A from Stack
		7	Stack Pointer + 4	1	Index Register from Stack (High Order Byte)
		8	Stack Pointer + 5	1	Index Register from Stack (Low Order Byte)
		9	Stack Pointer + 6	1	Next Instruction Address from Stack (High Order Byte)
		10	Stack Pointer + 7	1	Next Instruction Address from Stack (Low Order Byte)
SWI	12	1	Op Code Address	1	Op Code
		2	Op Code Address + 1	1	Irrelevant Data
		3	Stack Pointer	0	Return Address (Low Order Byte)
		4	Stack Pointer - 1	0	Return Address (High Order Byte)
		5	Stack Pointer - 2	0	Index Register (Low Order Byte)
		6	Stack Pointer - 3	0	Index Register (High Order Byte)
		7	Stack Pointer - 4	0	Contents of Accumulator A
		8	Stack Pointer - 5	0	Contents of Accumulator B
		9	Stack Pointer - 6	0	Contents of Cond. Code Register
		10	Stack Pointer - 7	1	Irrelevant Data
		11	Vector Address FFFA (Hex)	1	Address of Subroutine (High Order Byte)
		12	Vector Address FFFB (Hex)	1	Address of Subroutine (Low Order Byte)

(Continued)

** While the MPU is in the "Wait" state, its bus state will appear as a series of MPU reads of an address which is seven locations less than the original contents of the Stack Pointer. Contrary to the HD6800, none of the ports are driven to the high impedance state by a WAI instruction.

Table 12 Cycle by Cycle Operation (Continued)

RELATIVE

Address Mode & Instructions	Cycles	Cycle #	Address Bus	R/W Line	Data Bus
BCC BHT BNE BCS BLE BPL BEQ BLS BRA BGE BLT BVC BGT BMT BVS BRN	3	1	Op Code Address	1	Op Code
		2	Op Code Address + 1	1	Branch Offset
		3	Address Bus FFFF	1	Low Byte of Restart Vector
BSR	6	1	Op Code Address	1	Op Code
		2	Op Code Address + 1	1	Branch Offset
		3	Address Bus FFFF	1	Low Byte of Restart Vector
		4	Subroutine Starting Address	1	Op Code of Next Instruction
		5	Stack Pointer	0	Return Address (Low Order Byte)
		6	Stack Pointer - 1	0	Return Address (High Order Byte)

● Summary of Undefined Instruction Operations

The HD6803 has 36 undefined instructions. When these are carried out, the contents of Register and Memory in MPU change at random.

When the op codes (4E, 5E) are used to execute, the MPU continues to increase the program counter and it will not stop until the Reset signal enters. These op codes are used to test the LSI.

Table 13 Op codes Map

HD6803 MICROPROCESSOR INSTRUCTIONS																	
OP CODE								ACCA or SP				ACCB or X					
	HI	0000	0001	0010	0011	ACC A 0100	ACC B 0101	IND 0110	EXT 0111	IMM 1000	DIR 1001	IND 1010	EXT 1011	IMM 1100	DIR 1101	IND 1110	EXT 1111
LO	0	1	2	3	4	5	6	7	8	9	A	B	C	D	E	F	
0000	0		SBA	BRA	TSX	NEG				SUB				0			
0001	1	NOP	CBA	BRN	INS					CMP				1			
0010	2			BHI	PULA (+1)					SBC				2			
0011	3			BLS	PULB (+1)	COM		* SUBD (+2)		* ADDD (+2)		3					
0100	4	LSRD (+1)		BCC	DES	LSR		AND				4					
0101	5	ASLD (+1)		BCS	TXS	BIT				5							
0110	6	TAP	TAB	BNE	PSHA	ROR		LDA				6					
0111	7	TPA	TBA	BEQ	PSHB	ASR		STA		STA		7					
1000	8	INX (+1)		BVC	PULX (+2)	ASL		EOR				8					
1001	9	DEX (+1)	DAA	BVS	RTS (+2)	ROL		ADC				9					
1010	A	CLV		BPL	ABX	DEC		ORA				A					
1011	B	SEV	ABA	BMI	RTI (+7)	ADD				B							
1100	C	CLC		BGE	PSHX (+1)	INC		* CPX (+2)		* LDD (+1)		C					
1101	D	SEC		BLT	MUL (+7)	TST		BSR (+4)		JSR (+2)		* (+1)		STD (+1)		D	
1110	E	CLI		BGT	WAI (+6)	** JMP (-3)		* LDS (+1)		* LDX (+1)		E					
1111	F	SEI		BLE	SWI (+9)	CLR		* (+1)		STS (+1)		* (+1)		STX (+1)		F	
BYTE/CYCLE		1/2	1/2	2/3	1/3	1/2	1/2	2/6	3/6	2/2	2/3	2/4	3/4	2/2	2/3	2/4	3/4

- [NOTES]
- 1) Undefined Op codes are marked with .
 - 2) () indicate that the number in parenthesis must be added to the cycle count for that instruction.
 - 3) The instructions shown below are all 3 bytes and are marked with "***". Immediate addressing mode of SUBD, CPX, LDS, ADDD, LDD and LDX instructions, and undefined op codes (8F, CD, CF).
 - 4) The Op codes (4E, 5E) are 1 byte/∞ cycles instructions, and are marked with "****"

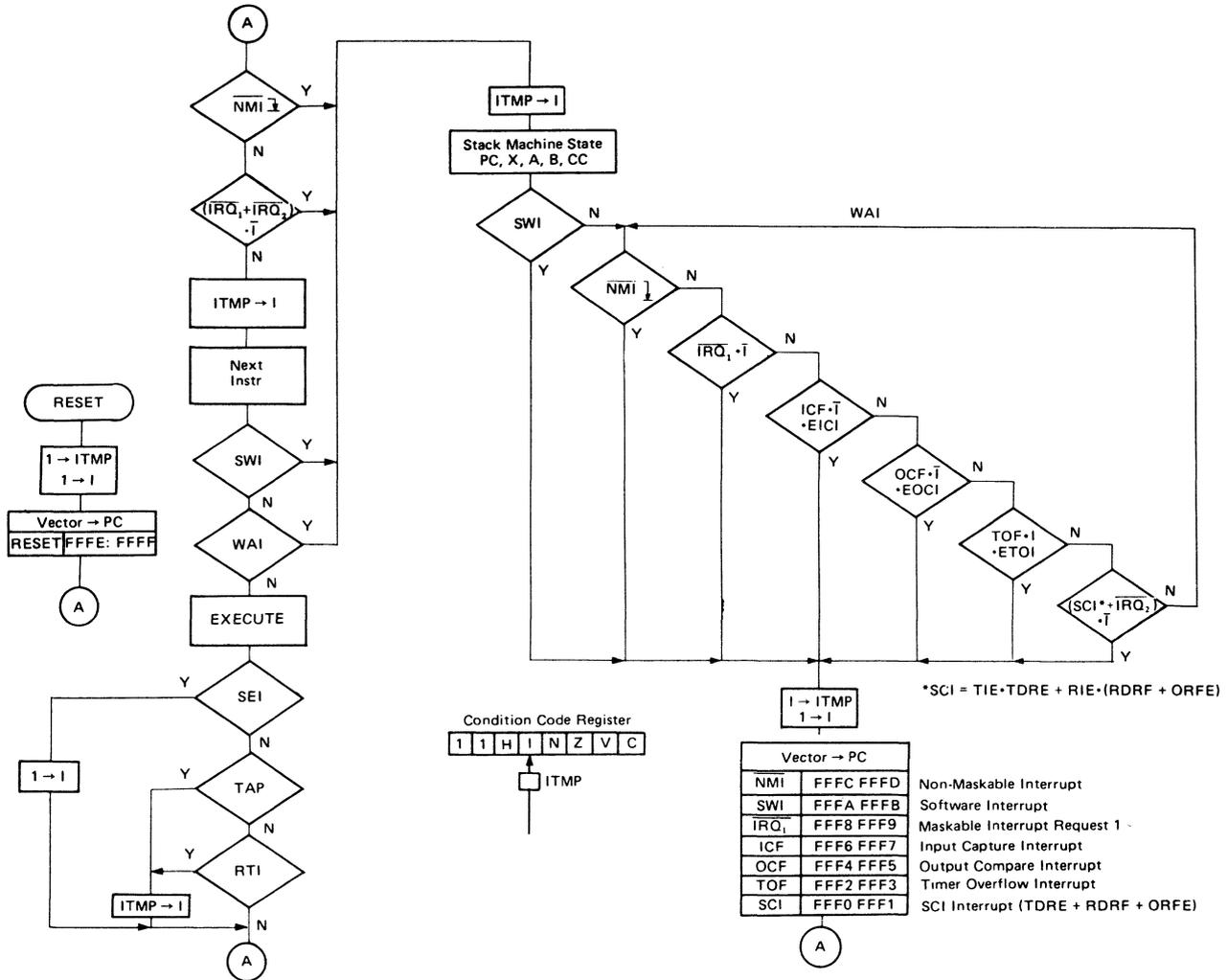


Figure 16 Interrupt Flowchart

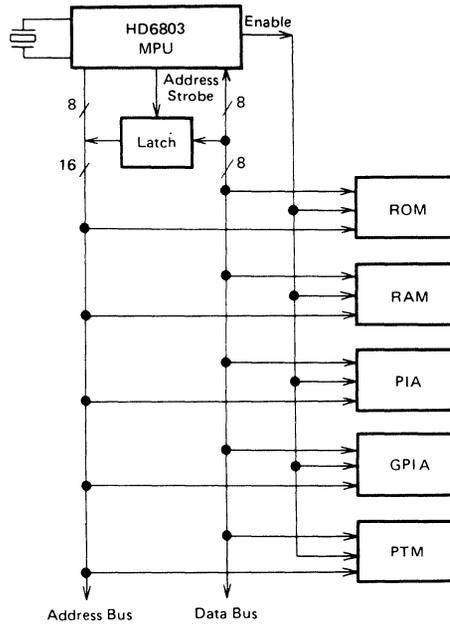


Figure 17 HD6803 MPU Expanded Multiplexed Bus



HD6303R, HD63A03R, HD63B03R

CMOS MPU (Micro Processing Unit)

The HD6303R is an 8-bit CMOS micro processing unit which has the completely compatible instruction set with the HD6301V1. 128 bytes RAM, Serial Communication Interface (SCI), parallel I/O ports and multi function timer are incorporated in the HD6303R. It is bus compatible with HMCS6800 and can be expanded up to 65k words. Like the HMCS6800 family, I/O levels is TTL compatible with +5.0V single power supply. As the HD6303R is CMOS MPU, power dissipation is extremely low. And also HD6303R has Sleep Mode and Stand-by Mode as lower power dissipation mode. Therefore, flexible low power consumption application is possible.

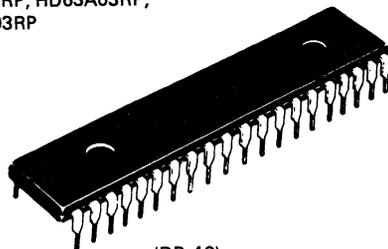
■ FEATURES

- Object Code Upward Compatible with the HD6800, HD6801, HD6802
- Multiplexed Bus ($D_0 \sim D_7/A_0 \sim A_7$), Non Multiplexed Bus
- Abundant On-Chip Functions Compatible with the HD6301V1; 128 Bytes RAM, 13 Parallel I/O Lines, 16-bit Timer, Serial Communication Interface (SCI)
- Low Power Consumption Mode; Sleep Mode, Stand-By Mode
- Minimum Instruction Execution Time
 $1\mu\text{s}$ ($f=1\text{MHz}$), $0.67\mu\text{s}$ ($f=1.5\text{MHz}$), $0.5\mu\text{s}$ ($f=2.0\text{MHz}$)
- Bit Manipulation, Bit Test Instruction
- Error Detecting Function; Address Trap, Op Code Trap
- Up to 65k Words Address Space

■ TYPE OF PRODUCTS

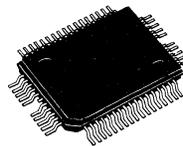
Type No.	Bus Timing
HD6303R	1.0 MHz
HD63A03R	1.5 MHz
HD63B03R	2.0 MHz

HD6303RP, HD63A03RP,
HD63B03RP



(DP-40)

HD6303RF, HD63A03RF,
HD63B03RF



(FP-54)

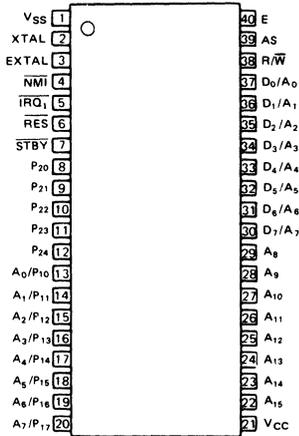
HD6303RCG, HD63A03RCG,
HD63B03RCG



(CG-40)

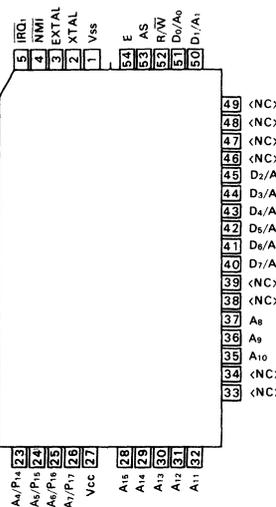
■ PIN ARRANGEMENT

- HD6303RP, HD63A03RP, HD63B03RP



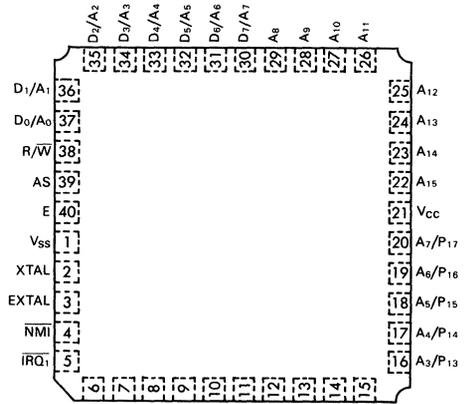
(Top View)

- HD6303RF, HD63A03RF, HD63B03RF



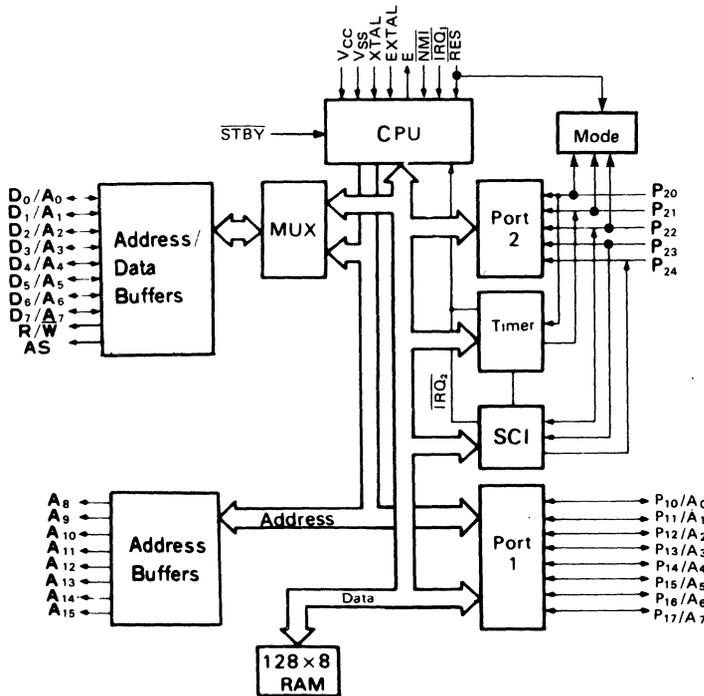
(Top View)

- HD6303RCG, HD63A03RCG, HD63B03RCG



(Top View)

■ BLOCK DIAGRAM



■ ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Value	Unit
Supply Voltage	V_{CC}	-0.3 ~ +7.0	V
Input Voltage	V_{in}	-0.3 ~ $V_{CC}+0.3$	V
Operating Temperature	T_{opr}	0 ~ +70	°C
Storage Temperature	T_{stg}	-55 ~ +150	°C

(NOTE) This product has protection circuits in input terminal from high static electricity voltage and high electric field. But be careful not to apply overvoltage more than maximum ratings to these high input impedance protection circuits. To assure the normal operation, we recommend $V_{in}, V_{out} : V_{SS} \leq (V_{in} \text{ or } V_{out}) \leq V_{CC}$.

■ ELECTRICAL CHARACTERISTICS

- DC CHARACTERISTICS ($V_{CC} = 5.0V \pm 10\%$, $V_{SS} = 0V$, $T_a = 0 \sim +70^\circ C$, unless otherwise noted.)

Item	Symbol	Test Condition	min	typ	max	Unit	
Input "High" Voltage	RES, STBY	V_{IH}	$V_{CC}-0.5$	-	$V_{CC}+0.3$	V	
	EXTAL		$V_{CC} \times 0.7$	-			
	Other Inputs		2.0	-			
Input "Low" Voltage	All Inputs	V_{IL}	-0.3	-	0.8	V	
Input Leakage Current	NMI, \overline{IRQ}_1 , RES, STBY	$ I_{in} $	$V_{in} = 0.5 \sim V_{CC}-0.5V$	-	-	1.0	μA
Three State (off-state) Leakage Current	$P_{10} \sim P_{17}, P_{20} \sim P_{24}, D_0 \sim D_7, A_8 \sim A_{15}$	$ I_{TSI} $	$V_{in} = 0.5 \sim V_{CC}-0.5V$	-	-	1.0	μA
Output "High" Voltage	All Outputs	V_{OH}	$I_{OH} = -200\mu A$	2.4	-	-	V
			$I_{OH} = -10\mu A$	$V_{CC}-0.7$	-	-	V
Output "Low" Voltage	All Outputs	V_{OL}	$I_{OL} = 1.6mA$	-	-	0.55	V
Input Capacitance	All Inputs	C_{in}	$V_{in} = 0V, f = 1.0MHz, T_a = 25^\circ C$	-	-	12.5	pF
Standby Current	Non Operation	I_{CC}		-	2.0	15.0	μA
Current Dissipation*		I_{CC}	Operating (f=1MHz)**	-	6.0	10.0	mA
			Sleeping (f=1MHz)**	-	1.0	2.0	
RAM Stand-By Voltage		V_{RAM}		2.0	-	-	V

* $V_{IH} \text{ min} = V_{CC}-1.0V, V_{IL} \text{ max} = 0.8V$

** Current Dissipation of the operating or sleeping condition is proportional to the operating frequency. So the typ. or max. values about Current Dissipations at f = x MHz operation are decided according to the following formula;

typ. value (f = x MHz) = typ. value (f = 1MHz) x x
 max. value (f = x MHz) = max. value (f = 1MHz) x x
 (both the sleeping and operating)

● AC CHARACTERISTICS (V_{CC} = 5.0V±10%, V_{SS} = 0V, T_a = 0~+70°C, unless otherwise noted.)

BUS TIMING

Item	Symbol	Test Condition	HD6303R			HD63A03R			HD63B03R			Unit	
			min	typ	max	min	typ	max	min	typ	max		
Cycle Time	t _{cyc}	Fig. 1 Fig. 2	1	—	10	0.666	—	10	0.5	—	10	μs	
Address Strobe Pulse Width "High"	PW _{ASH}		220	—	—	150	—	—	110	—	—	ns	
Address Strobe Rise Time	t _{ASr}		—	—	20	—	—	20	—	—	20	ns	
Address Strobe Fall Time	t _{ASf}		—	—	20	—	—	20	—	—	20	ns	
Address Strobe Delay Time	t _{ASD}		60	—	—	40	—	—	20	—	—	ns	
Enable Rise Time	t _{Er}		—	—	20	—	—	20	—	—	20	ns	
Enable Fall Time	t _{Ef}		—	—	20	—	—	20	—	—	20	ns	
Enable Pulse Width "High" Level	PW _{EH}		450	—	—	300	—	—	220	—	—	ns	
Enable Pulse Width "Low" Level	PW _{EL}		450	—	—	300	—	—	220	—	—	ns	
Address Strobe to Enable Delay Time	t _{ASED}		60	—	—	40	—	—	20	—	—	ns	
Address Delay Time	t _{AD1}		—	—	250	—	—	190	—	—	160	ns	
	t _{AD2}		—	—	250	—	—	190	—	—	160	ns	
Address Delay Time for Latch	t _{ADL}		—	—	250	—	—	190	—	—	160	ns	
Data Set-up Time	Write		t _{DSW}	230	—	—	150	—	—	100	—	—	ns
	Read		t _{DSR}	80	—	—	60	—	—	50	—	—	ns
Data Hold Time	Read		t _{HR}	0	—	—	0	—	—	0	—	—	ns
	Write		t _{HW}	20	—	—	20	—	—	20	—	—	ns
Address Set-up Time for Latch	t _{ASL}		60	—	—	40	—	—	20	—	—	ns	
Address Hold Time for Latch	t _{AHL}		30	—	—	20	—	—	20	—	—	ns	
Address Hold Time	t _{AH}		20	—	—	20	—	—	20	—	—	ns	
A ₀ ~ A ₇ Set-up Time Before E	t _{ASM}	200	—	—	110	—	—	60	—	—	ns		
Peripheral Read Access Time	Non-Multiplexed Bus	(t _{ACCN})	—	—	650	—	—	395	—	—	270	ns	
	Multiplexed Bus	(t _{ACCM})	—	—	650	—	—	395	—	—	270	ns	
Oscillator stabilization Time	t _{RC}	Fig. 8	20	—	—	20	—	—	20	—	—	ms	
Processor Control Set-up Time	t _{PCS}	Fig. 9	200	—	—	200	—	—	200	—	—	ns	

PERIPHERAL PORT TIMING

Item	Symbol	Test Condition	HD6303R			HD63A03R			HD63B03R			Unit	
			min	typ	max	min	typ	max	min	typ	max		
Peripheral Data Set-up Time	Port 1, 2	t _{PDSU}	Fig. 3	200	—	—	200	—	—	200	—	—	ns
Peripheral Data Hold Time	Port 1, 2	t _{PDH}	Fig. 3	200	—	—	200	—	—	200	—	—	ns
Delay Time, Enable Negative Transition to Peripheral Data Valid	Port 1, 2*	t _{PWD}	Fig. 4	—	—	300	—	—	300	—	—	300	ns

* Except P₂₁

TIMER, SCI TIMING

Item	Symbol	Test Condition	HD6303R			HD63A03R			HD63B03R			Unit
			min	typ	max	min	typ	max	min	typ	max	
Timer Input Pulse Width	t_{PWT}		2.0	-	-	2.0	-	-	2.0	-	-	t_{cyc}
Delay Time, Enable Positive Transition to Timer Out	t_{TOD}	Fig. 5	-	-	400	-	-	400	-	-	400	ns
SCI Input Clock Cycle	t_{Scyc}		2.0	-	-	2.0	-	-	2.0	-	-	t_{cyc}
SCI Input Clock Pulse Width	t_{PWCK}		0.4	-	0.6	0.4	-	0.6	0.4	-	0.6	t_{Scyc}

MODE PROGRAMMING

Item	Symbol	Test Condition	HD6303R			HD63A03R			HD63B03R			Unit
			min	typ	max	min	typ	max	min	typ	max	
RES "Low" Pulse Width	PW_{RSTL}		3	-	-	3	-	-	3	-	-	t_{cyc}
Mode Programming Set-up Time	t_{MPS}	Fig. 6	2	-	-	2	-	-	2	-	-	t_{cyc}
Mode Programming Hold Time	t_{MPH}		150	-	-	150	-	-	150	-	-	ns

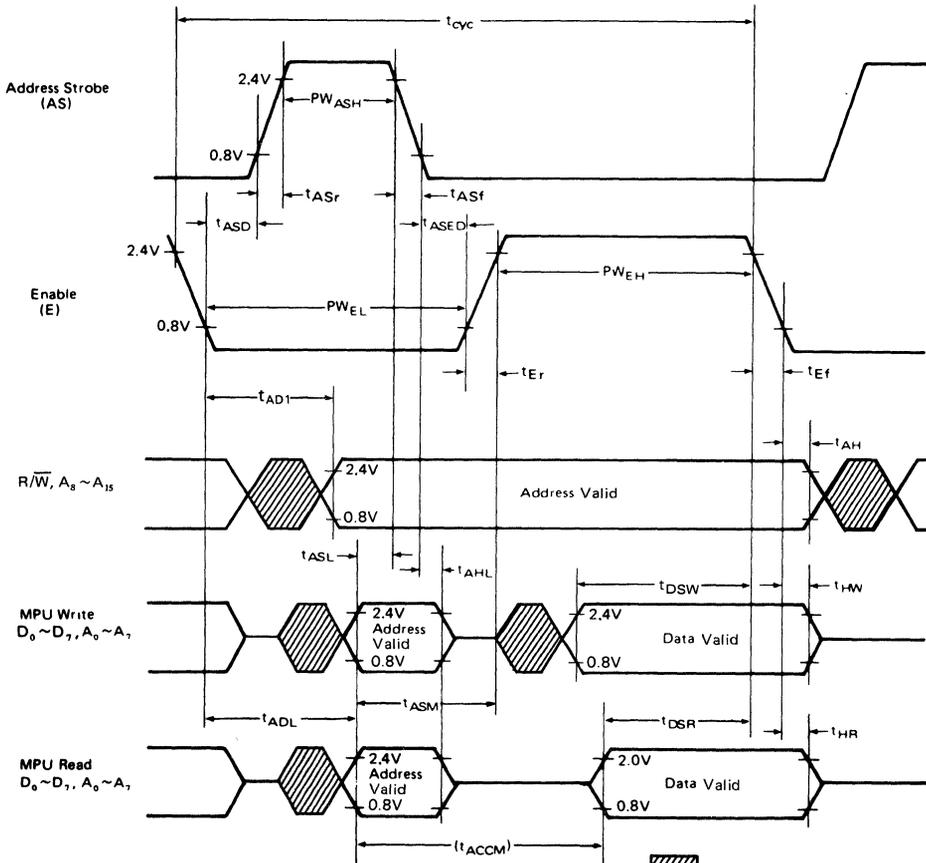


Figure 1 Multiplexed Bus Timing

Not Valid

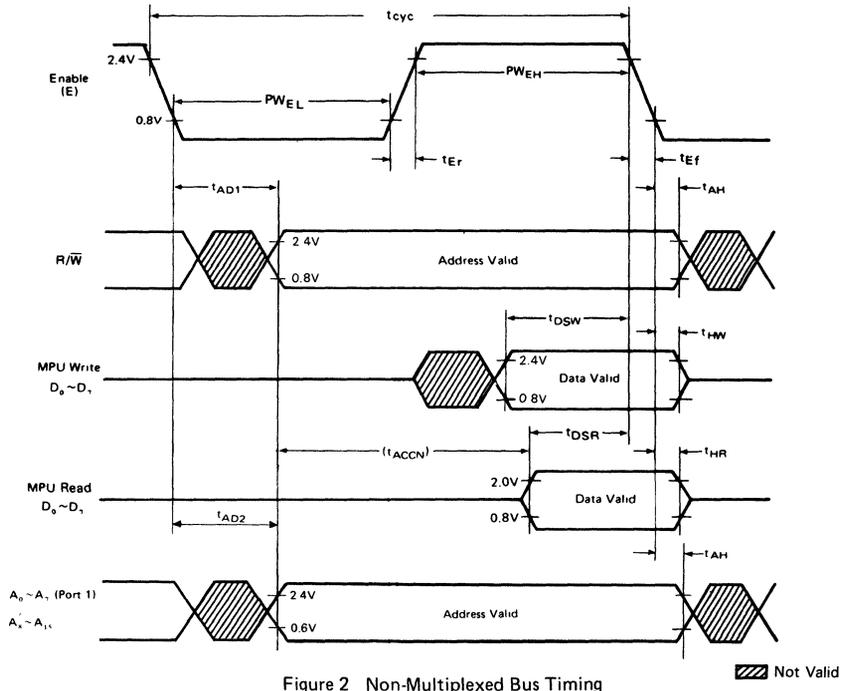


Figure 2 Non-Multiplexed Bus Timing

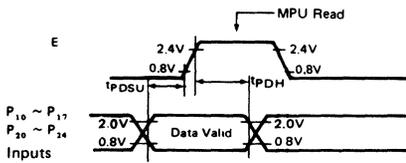
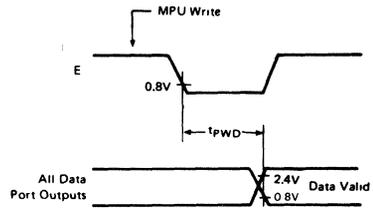


Figure 3 Port Data Set-up and Hold Times (MPU Read)



Note) Port 2: Except P_{2,1}
Figure 4 Port Data Delay Times (MPU Write)

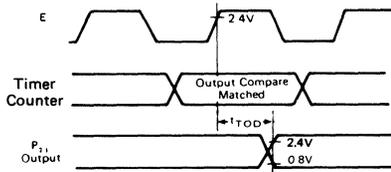


Figure 5 Timer Output Timing

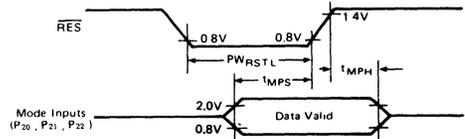


Figure 6 Mode Programming Timing

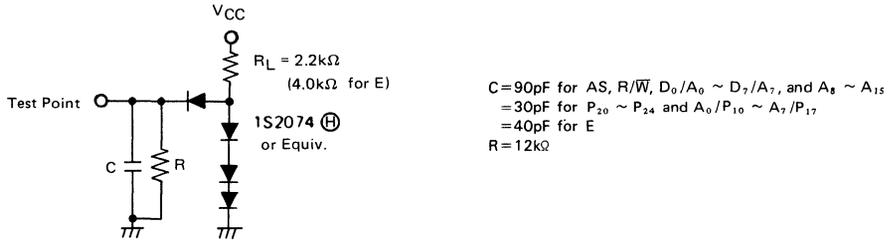


Figure 7 Bus Timing Test Loads (TTL Load)

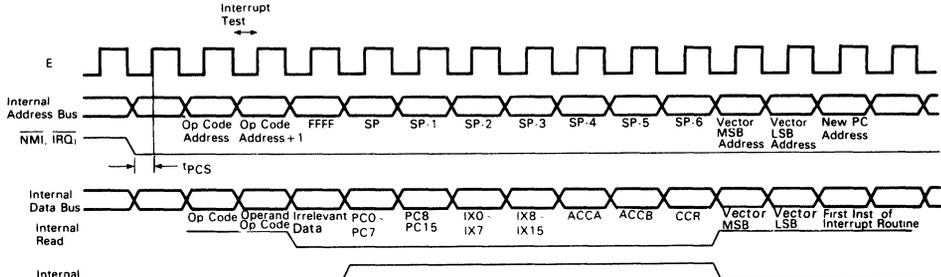


Figure 8 Interrupt Sequence

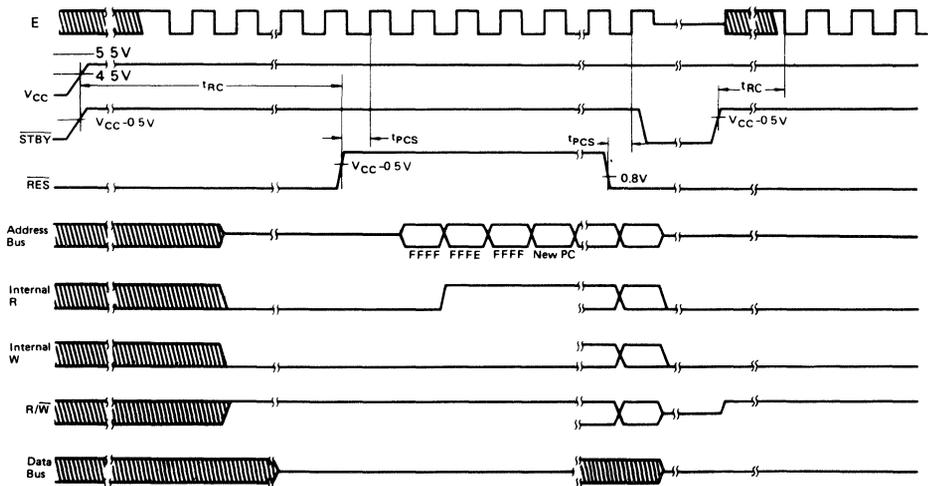


Figure 9 Reset Timing

FUNCTIONAL PIN DESCRIPTION

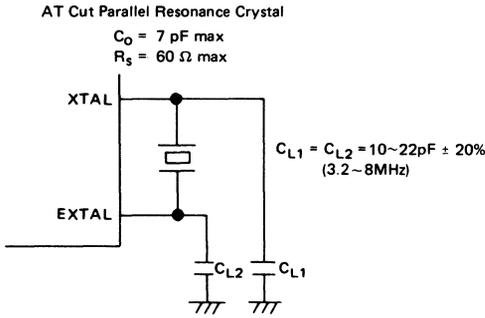
VCC, VSS

These two pins are used for power supply and GND. Recommended power supply voltage is 5V ± 10%. 3 to 6V can be used for low speed operation (100 ~ 500 kHz).

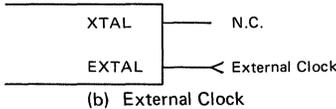
XTAL, EXTAL

These two pins are connected with parallel resonant funda-

mental crystal, AT cut. For instance, in order to obtain the system clock 1MHz, a 4MHz resonant fundamental crystal is used because the device by 4 circuitry is included. EXTAL accepts an external clock input of duty 50% (±10%) to drive. For external driving XTAL pin should be open. An example of connection circuit is shown in Fig. 10. The crystal and capacitors should be mounted as close as possible to the pins.



(a) Crystal Interface



(b) External Clock

Figure 10 Connection Circuit

● Standby (\overline{STBY})

This pin is used to place the MPU in the standby mode. If this goes to “Low” level, the oscillation stops, the internal clock is tied to V_{SS} or V_{CC} and the MPU is reset. In order to retain information in RAM during standby, write “0” into RAM enable bit (RAME). RAME is bit 6 of the RAM Control Register at address \$0014. This disables the RAM, so the contents of RAM is guaranteed. For details of the standby mode, see the Standby section.

● Reset (\overline{RES})

This input is used to reset the MPU. \overline{RES} must be held “Low” for at least 20ms when the power starts up. It should be noted that, before clock generator stabilize, the internal state and I/O ports are uncertain, because MPU can not be reset without clock. To reset the MPU during system operation, it must be held “Low” for at least 3 system clock cycles. From the third cycle, all address buses become “high-impedance” and it continues while RES is “Low”. If RES goes to “High”, CPU does the following.

- (1) I/O Port 2 bits 2,1,0 are latched into bits PC2, PC1, PC0 of program control register.
- (2) The contents of the two Start Addresses, \$FFFE, \$FFFF are brought to the program counter, from which program starts (see Table 1).
- (3) The interrupt mask bit is set. In order to have the CPU recognize the maskable interrupts $\overline{IRQ_1}$ and $\overline{IRQ_2}$, clear it before those are used.

● Enable (E)

This output pin supplies system clock. Output is a single-phase, TTL compatible and 1/4 the crystal oscillation frequency. It will drive two LS TTL load and 40pF.

● Non Maskable Interrupt (\overline{NMI})

When the falling edge of the input signal of this pin is recognized, NMI sequence starts. The current instruction is continued to complete, even if \overline{NMI} signal is detected. Interrupt mask bit in Condition Code Register has no effect on NMI detection. In response to NMI interrupt, the information of

Program Counter, Index Register, Accumulators, and Condition Code Register are stored on the stack. On completion of this sequence, vectoring address \$FFFC and \$FFFD are generated to load the contents to the program counter. Then the CPU branch to a non maskable interrupt service routine.

● Interrupt Request ($\overline{IRQ_1}$)

This level sensitive input requests a maskable interrupt sequence. When $\overline{IRQ_1}$ goes to “Low”, the CPU waits until it completes the current instruction that is being executed. Then, if the interrupt mask bit in Condition Code Register is not set, CPU begins interrupt sequence; otherwise, interrupt request is neglected.

Once the sequence has started, the information of Program Counter, Index Register, Accumulator, Condition Code Register are stored on the stack. Then the CPU sets the interrupt mask bit so that no further maskable interrupts may be responded.

Table 1 Interrupt Vectoring memory map

Highest Priority	Vector		Interrupt
	MSB	LSB	
	FFFE	FFFF	RES
	FFEE	FFEF	TRAP
	FFFC	FFFD	NMI
	FFFA	FFFB	Software Interrupt (SWI)
	FFF8	FFF9	$\overline{IRQ_1}$ (or $iS3$)
	FFF6	FFF7	ICF (Timer Input Capture)
	FFF4	FFF5	OCF (Timer Output Compare)
	FFF2	FFF3	TOF (Timer Overflow)
Lowest Priority	FFF0	FFF1	SCI (RDRF + ORFE + TDRE)

At the end of the cycle, the CPU generates 16 bit vectoring addresses indicating memory addresses \$FFF8 and \$FFF9, and loads the contents to the Program Counter, then branch to an interrupt service routine.

The Internal Interrupt will generate signal ($\overline{IRQ_2}$) which is quite the same as $\overline{IRQ_1}$ except that it will use the vector address \$FFF0 to \$FFF7.

When $\overline{IRQ_1}$ and $\overline{IRQ_2}$ are generated at the same time, the former precede the latter. Interrupt Mask Bit in the condition code register, if being set, will keep the both interrupts off.

On occurrence of Address error or Op-code error, TRAP interrupt is invoked. This interrupt has priority next to RES. Regardless of the interrupt Mask Bit condition, the CPU will start an interrupt sequence. The vector for this interrupt will be \$FFEE, \$FFEF.

● Read/Write (R/ \overline{W})

This TTL compatible output signal indicates peripheral and memory devices whether CPU is in Read (“High”), or in Write (“Low”). The normal stand-by state is Read (“High”). Its output will drive one TTL load and 90pF.

● Address Strobe (AS)

In the multiplexed mode, address strobe signal appears at this pin. It is used to latch the lower 8 bits addresses multiplexed with data at $D_0/A_0 \sim D_7/A_7$. The 8-bit latch is controlled by address strobe as shown in Figure 15. Thereby, $D_0/A_0 \sim D_7/A_7$ can become data bus during E pulse. The timing chart of this signal is shown in Figure 1.

Address Strobe (AS) is sent out even if the internal address is accessed.

■ PORTS

There are two I/O ports on HD6303R MPU (one 8-bit ports and one 5-bit port). Each port has an independent write-only data direction register to program individual I/O pins for

input or output.*

When the bit of associated Data Direction Register is "1", I/O pin is programmed for output, if "0", then programmed for an input.

There are two ports: Port 1, Port 2. Addresses of each port and associated Data Direction Register are shown in Table 2.

* Only one exception is bit 1 of Port 2 which becomes either a data input or a timer output. It cannot be used as an output port.

Table 2 Port and Data Direction Register Addresses

Ports	Port Address	Data Direction Register Address
I/O Port 1	\$0002	\$0000
I/O Port 2	\$0003	\$0001

● I/O Port 1

This is an 8-bit port, each bit being defined individually as input or outputs by associated Data Direction Register. The 8-bit output buffers have three-state capability, maintaining in high impedance state when they are used for input. In order to be read accurately, the voltage on the input lines must be more than 2.0V for logic "1" and less than 0.8V for logic "0".

These are TTL compatible. After the MPU has been reset, all I/O lines are configured as inputs in Multiplexed mode. In Non Multiplexed mode, Port 1 will be output line for lower order address lines (A₀ ~ A₇), which can drive one TTL load and 30 pF.

● I/O Port 2

This port has five lines, whose I/O direction depends on its data direction register. The 5-bit output buffers have three-state capability, going high impedance state when used as inputs. In order to be read accurately, the voltage on the input lines must be more than 2.0V for logic "1" and less than 0.8V for logic "0". After the MPU has been reset, I/O lines are configured as inputs. These pins on Port 2 (P₂₀ ~ P₂₂ of the chip) are used to program the mode of operation during reset. The values of these three pins during reset are latched into the upper 3 bits (bit 7, 6 and 5) of Port 2 Data Register which is explained in the MODE SELECTION section.

In all modes, Port 2 can be configured as I/O lines. This port also provides access to the Serial I/O and the Timer. However, note that bit 1 (P₂₁) is the only pin restricted to data input or Timer output.

■ BUS

● D₀/A₀ ~ D₇/A₇

This TTL compatible three-state buffer can drive one TTL load and 90 pF.

Non Multiplexed Mode

In this mode, these pins become only data bus (D₀ ~ D₇).

Multiplexed Mode

These pins becomes both the data bus (D₀ ~ D₇) and lower bits of the address bus (A₀ ~ A₇). An address strobe output is "High" when the address is on the pins.

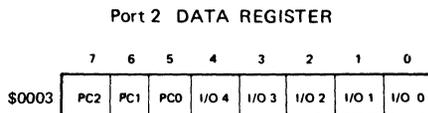
● A₈ ~ A₁₅

Each line is TTL compatible and can drive one TTL load and

90 pF. After reset, these pins become output for upper order address lines (A₈ ~ A₁₅).

■ MODE SELECTION

The operation mode after the rest must be determined by the user wiring the P₂₀, P₂₁, and P₂₂ externally. These three pins are lower order bits; I/O 0, I/O 1, I/O 2 of Port 2. They are latched into the control bits PC₀, PC₁, PC₂ of I/O Port 2 register when \overline{RES} goes "High". I/O Port 2 Register is shown below.



An example of external hardware used for Mode Selection is shown in Figure 11. The HD14053B is used to separate the peripheral device from the MPU during reset. It is necessary if the data may conflict between peripheral device and Mode generation circuit.

No mode can be changed through software because the bits 5, 6, and 7 of Port 2 Data Register are read-only. The mode selection of the HD6303R is shown in Table 3.

The HD6303R operates in two basic modes: (1) Multiplexed Mode, (2) Non Multiplexed Mode.

● Multiplexed Mode

The data bus and the lower order address bus are multiplexed in the D₀/A₀ ~ D₇/A₇ and can be separated by the Address Strobe.

Port 2 is configured for 5 parallel I/O or Serial I/O, or Timer, or any combination thereof. Port 1 is configured for 8 parallel I/O.

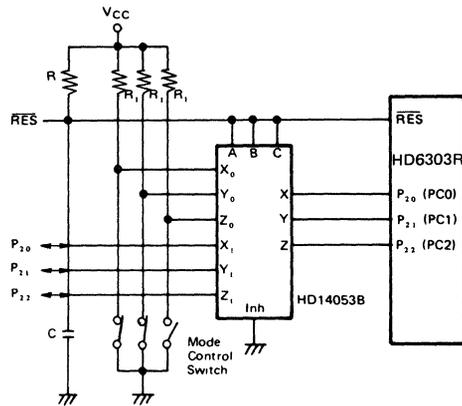
● Non Multiplexed Mode

In this mode, the HD6303R can directly address HMCS6800 peripherals with no external logic. D₀/A₀ ~ D₇/A₇ become a data bus and Port 1 becomes A₀ ~ A₇ address bus.

In this mode, the HD6303R is expandable up to 65k words with no external logic.

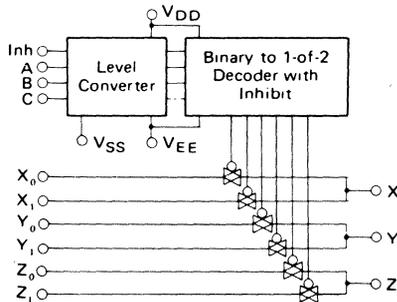
● Lower Order Address Bus Latch

Because the data bus is multiplexed with the lower order address bus in D₀/A₀ ~ D₇/A₇ in the multiplexed mode, address bits must be latched. It requires the 74LS373 Transparent octal D-type to latch the LSB. Latch connection of the HD6303R is shown in Figure 15.



Note 1) Figure of Multiplexed Mode
 2) $R_C \approx$ Reset Constant
 3) $R_1 = 10k\Omega$

Figure 11 Recommended Circuit for Mode Selection



Truth Table

Control Input			On Switch			
Inhibit	Select		HD14053B			
	C	B	A	Z_0	Y_0	X_0
0	0	0	0	Z_0	Y_0	X_0
0	0	0	1	Z_0	Y_0	X_1
0	0	1	0	Z_0	Y_1	X_0
0	0	1	1	Z_0	Y_1	X_1
0	1	0	0	Z_1	Y_0	X_0
0	1	0	1	Z_1	Y_0	X_1
0	1	1	0	Z_1	Y_1	X_0
0	1	1	1	Z_1	Y_1	X_1
1	X	X	X	-	-	-

Figure 12 HD14053B Multiplexers/De-Multiplexers

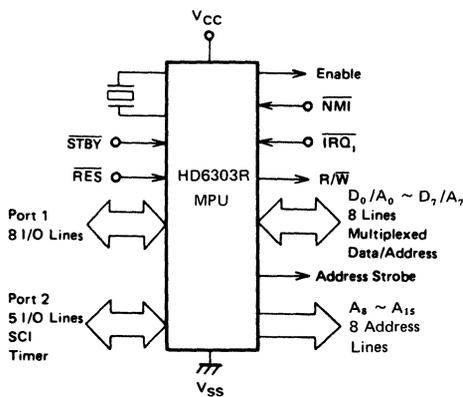


Figure 13 HD6303R MPU Multiplexed Mode

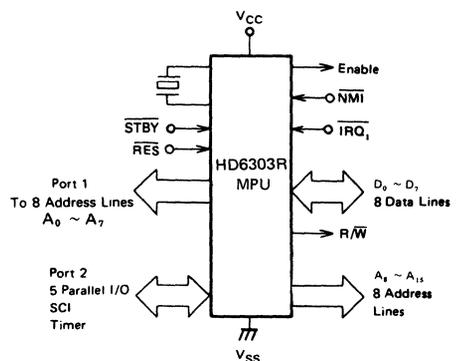


Figure 14 HD6303R MPU Non Multiplexed Mode

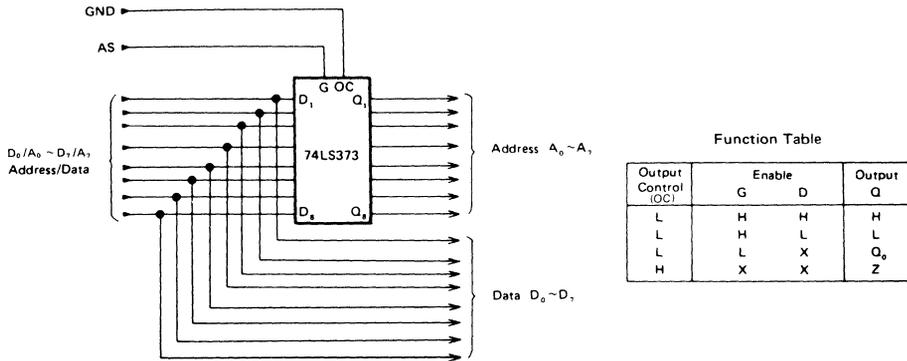


Figure 15 Latch Connection

Table 3 Mode Selection

Operating Mode	P ₂₀	P ₂₁	P ₂₂
Multiplexed Mode	L	H	L
	L	L	H
Non Multiplexed Mode	H	L	L

L: logic "0"
H: logic "1"

■ MEMORY MAP

The MPU can provide up to 65k byte address space. Figure 16 shows a memory map for each operating mode. The first 32 locations of each map are for the CPU's internal register only, as shown in Table 4.

Table 4 Internal Register Area

Register	Address
Port 1 Data Direction Register**	00*
Port 2 Data Direction Register**	01
Port 1 Data Register	02*
Port 2 Data Register	03
Timer Control and Status Register	08
Counter (High Byte)	09
Counter (Low Byte)	0A
Output Compare Register (High Byte)	0B
Output Compare Register (Low Byte)	0C
Input Capture Register (High Byte)	0D
Input Capture Register (Low Byte)	0E
Rate and Mode Control Register	10
Transmit/Receive Control and Status Register	11
Receive Data Register	12
Transmit Data Register	13
RAM Control Register	14
Reserved	15-1F

* External address in Non Multiplexed Mode
** 1 = Output, 0 = Input

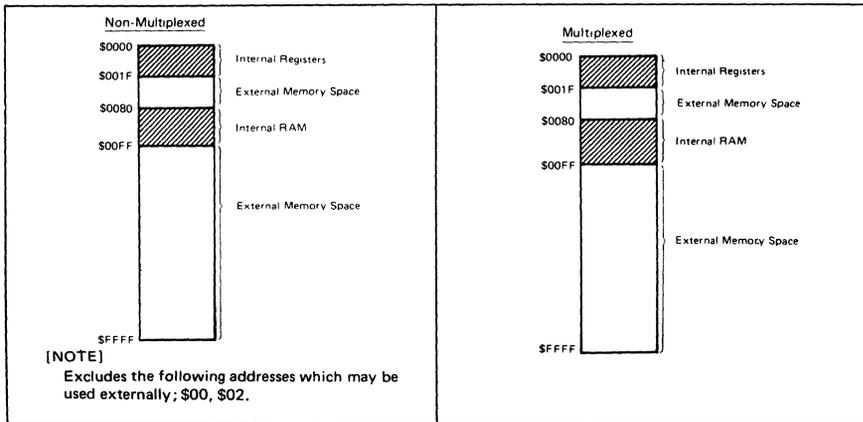


Figure 16 HD6303R Memory Maps

■ PROGRAMMABLE TIMER

The HD6303R contains 16-bit programmable timer which may be used to make measurement of input waveform. In addition to that it can generate an output waveform by itself. For both input and output waveform, the pulse width may vary from a few microseconds to several seconds.

The timer hardware consists of

- an 8-bit control and status register
- a 16-bit free running counter
- a 16-bit output compare register, and
- a 16-bit input capture register

A block diagram of the timer is shown in Figure 17.

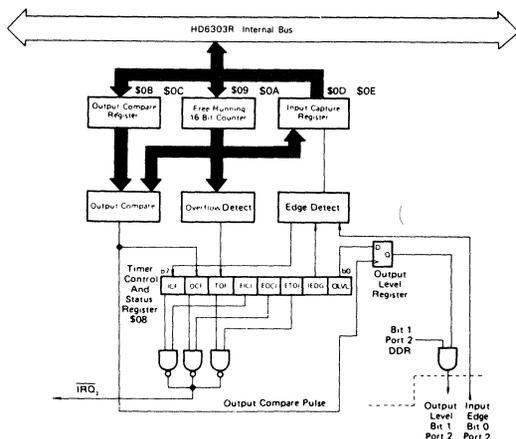


Figure 17 Programmable Timer Block Diagram

● Free Running Counter (\$0009: \$000A)

The key element in the programmable timer is a 16-bit free running counter, that is driven by an E (Enable) clock to increment its values. The counter value will be read out by the CPU software at any time with no effects on the counter. Reset will clear the counter.

When the MSB of this counter is read, the LSB is stored in temporary latch. The data is fetched from this latch by the subsequent read of LSB. Thus consistent double byte data can be read from the counter.

When the CPU writes arbitrary data to the MSB (\$09), the value of \$FFF8 is being pre-set to the counter (\$09, \$0A) regardless of the write data value. Then the CPU writes arbitrary data to the LSB (\$0A), the data is set to the "Low" byte of the counter, at the same time, the data preceedingly written in the MSB (\$09) is set to "High" byte of the counter.

When the data is written to this counter, a double byte store instruction (ex. STD) must be used. If only the MSB of counter is written, the counter is set to \$FFF8.

The counter value written to the counter using the double byte store instruction is shown in Figure 18.

To write to the counter can disturb serial operations, so it should be inhibited during using the SCI. If external clock mode is used for SCI, this will not disturb serial operations.

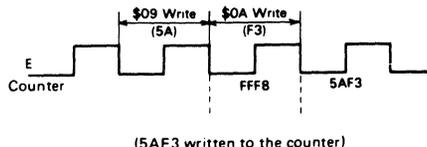


Figure 18 Counter Write Timing

● Output Compare Register (\$000B: \$000C)

This is a 16-bit read/write register which is used to control an output waveform. The contents of this register are constantly being compared with current value of the free running counter.

When the contents match with the value of the free running counter, a flag (OCF) in the timer control/status register (TCSR) is set and the current value of an output level bit (OLVL) in the TCSR is transferred to Port 2 bit 1. When bit 1 of the Port 2 data direction register is "1" (output), the OLVL value will appear on the bit 1 of Port 2. Then, the value of Output Compare Register and Output level bit may be changed for the next compare.

The output compare register is set to \$FFFF during reset.

The compare function is inhibited at the cycle of writing to the high byte of the output compare register and at the cycle just after that to ensure valid compare. It is also inhibited in same manner at writing to the free running counter.

In order to write a data to Output Compare Register, a double byte store instruction (ex.STD) must be used.

● Input Capture Register (\$000D: \$000E)

The input capture register is a 16-bit read-only register used to hold the current value of free running counter captured when the proper transition of an external input signal occurs.

The input transition change required to trigger the counter transfer is controlled by the input edge bit (IEDG).

To allow the external input signal to go in the edge detect unit, the bit of the Data Direction Register corresponding to bit 0 of Port 2 must have been cleared (to zero).

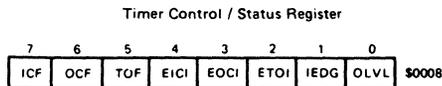
To insure input capture in all cases, the width of an input pulse requires at least 2 Enable cycles.

● Timer Control/Status Register (TCSR) (\$0008)

This is an 8-bit register. All 8-bits are readable and the lower 5 bits may be written. The upper 3 bits are read-only, indicating the timer status information as is shown below.

- (1) A proper transition has been detected on the input pin (ICF).
- (2) A match has been found between the value in the free running counter and the output compare register (OCF).
- (3) When counting up to \$0000 (TOF).

Each flag has an individual enable bit in TCSR which determines whether or not an interrupt request may occur (IRQ2). If the I-bit in Condition Code Register has been cleared, a priority vectored address occurs corresponding to each flag. A description of each bit is as follows.



Bit 0 OLVL (Output Level); When a match is found in the value between the counter and the output com-

pare register, this bit is transferred to the Port 2 bit 1. If the DDR corresponding to Port 2 bit 1 is set "1", the value will appear on the output pin of Port 2 bit 1.

Bit 1 IEDG (Input Edge): This bit control which transition of an input of Port 2 bit 0 will trigger the data transfer from the counter to the input capture register. The DDR corresponding to Port 2 bit 0 must be clear in advance of using this function.

When IEDG = 0, trigger takes place on a negative edge ("High"-to-"Low" transition). When IEDG = 1, trigger takes place on a positive edge ("Low"-to-"High" transition).

Bit 2 ETOI (Enable Timer Overflow Interrupt); When set, this bit enables TOF interrupt to generate the interrupt request (IRQ₂). When cleared, the interrupt is inhibited.

Bit 3 EOCI (Enable Output Compare Interrupt); When set, this bit enables OCF interrupt to generate the interrupt request (IRQ₂). When cleared, the interrupt is inhibited.

Bit 4 EICI (Enable Input Capture Interrupt); When set, this bit enables ICF interrupt to generate the interrupt request (IRQ₂). When cleared, the interrupt is inhibited.

Bit 5 TOF (Timer Over Flow Flag); This read-only bit is set at the transition of \$FFFF to \$0000 of the counter. It is cleared by CPU read of TCSR (with TOF set) followed by a CPU read of the counter (\$0009).

Bit 6 OCF (Output Compare Flag); This read-only bit is set when a match is found in the value between the output compare register and the counter. It is cleared by a read of TCSR (with OCF set) followed by a CPU write to the output compare register (\$000B or \$000C).

Bit 7 ICF (Input Capture Flag); The read-only bit is set by a proper transition on the input, and is cleared by a read of TCSR (with ICF set) followed by a CPU read of Input Capture Register (\$000D).

Reset will clear each bit of Timer Control and Status Register.

■ SERIAL COMMUNICATION INTERFACE

The HD6303R contains a full-duplex asynchronous Serial Communication Interface (SCI). SCI may select the several kinds of the data rate. It consists of a transmitter and a receiver which operate independently but with the same data format and the same data rate. Both of transmitter and receiver communicate with the CPU via the data bus and with the outside world through Port 2 bit 2, 3 and 4. Description of hardware, software and register is as follows.

● Wake-Up Feature

In typical multiprocessor applications the software protocol will usually have the designated address at the initial byte of the message. The purpose of Wake-Up feature is to have the non-selected MPU neglect the remainder of the message. Thus the non-selected MPU can inhibit the all further interrupt process until the next message begins.

Wake-Up feature is re-enabled by a ten consecutive "1"s which indicates an idle transmit line. Therefore software protocol must put an idle period between the messages and must prevent it within the message.

With this hardware feature, the non-selected MPU is re-enabled (or "waked-up") by the next message.

● Programmable Options

The HD6303R has the following programmable features.

- data format; standard mark/space (NRZ)
- clock source; external or internal
- baud rate; one of 4 rates per given E clock frequency or 1/8 of external clock
- wake-up feature; enabled or disabled
- interrupt requests; enabled or masked individually for transmitter and receiver
- clock output; internal clock enabled or disabled to Port 2 bit 2
- Port 2 (bits 3, 4); dedicated or not dedicated to serial I/O individually

● Serial Communication Hardware

The serial communications hardware is controlled by 4 registers as shown in Figure 19. The registers include:

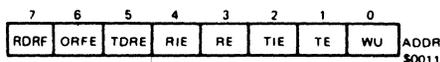
- an 8-bit control/status register
- a 4-bit rate/mode control register (write-only)
- an 8-bit read-only receive data register
- an 8-bit write-only transmit data register

Besides these 4 registers, Serial I/O utilizes Port 2 bit 3 (input) and bit 4 (output). Port 2 bit 2 can be used when an option is selected for the internal-clock-out or the external-clock-in.

● Transmit/Receive Control Status Register (TRCSR)

TRCS Register consists of 8 bits which all may be read while only bits 0 to 4 may be written. The register is initialized to \$20 on RES. The bits of the TRCS Register are explained below.

Transmit / Receive Control Status Register



Bit 0 WU (Wake Up); Set by software and cleared by hardware on receipt of ten consecutive "1"s. While this bit is "1", RDRF and ORFE flags are not set even if data are received or errors are detected. Therefore received data are ignored. It should be noted that RE flag must have already been set in advance of WU flag's set.

Bit 1 TE (Transmit Enable); This bit enables transmitter. When this bit is set, bit 4 of Port 2 DDR is also forced to be set. It remains set even if TE is cleared. Preamble of ten consecutive "1"s is transmitted just after this bit is set, and then transmitter becomes ready to send data. If this bit is cleared, the transmitter is disabled and serial I/O affects nothing on Port 2 bit 4.

Bit 2 TIE (Transmit Interrupt Enable); When this bit is set, TDRE (bit 5) causes an IRQ₂ interrupt. When cleared, TDRE interrupt is masked.

Bit 3 RE (Receive Enable); When set, Port 2 bit 3 can be used as an input of receive regardless of DDR value for this bit. When cleared, the receiver is disabled.

Bit 4 RIE (Receive Interrupt Enable); When this bit is set, RDRF (bit 7) or ORFE (bit 6) cause an IRQ₂ interrupt. When cleared, this interrupt is masked.

- Bit 5 TDRE (Transmit Data Register Empty);** When the data is transferred from the Transmit Data Register to Output Shift Register, this bit is set by hardware. The bit is cleared by reading the status register followed by writing the next new data into the Transmit Data Register. TDRE is initialized to 1 by RES.
- Bit 6 ORFE (Over Run Framing Error);** When overrun or framing error occurs (receive only), this bit is set by hardware. Over Run Error occurs if the attempt is made to transfer the new byte to the receive data register while the RDRF is "1". Framing Error occurs when the bit counter is not synchronized with the boundary of the byte in the re-

ceiving bit stream. When Framing Error is detected, RDRF is not set. Therefore Framing Error can be distinguished from Overrun Error. That is, if ORFE is "1" and RDRF is "1", Overrun Error is detected. Otherwise Framing Error occurs. The bit is cleared by reading the status register followed by reading the receive data register, or by RES.

Bit 7 RDRF (Receive Data Register Full); This bit is set by hardware when the data is transferred from the receive shift register to the receive data register. It is cleared by reading the status register followed by reading the receive data register, or by RES.

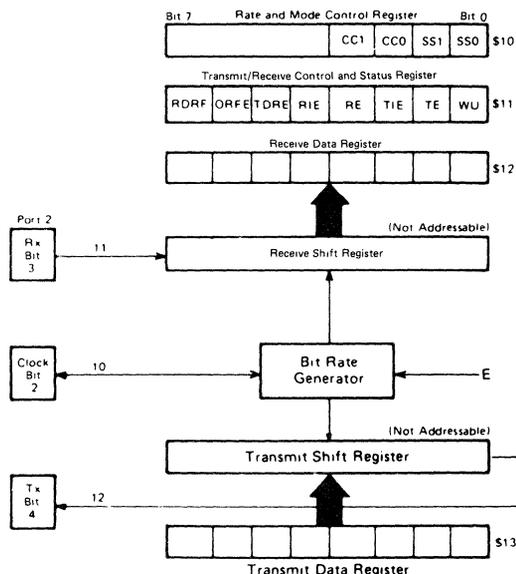


Figure 19 Serial I/O Register

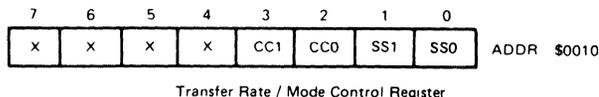


Table 5 SCI Bit Times and Transfer Rates

SS1 : SSO	XTAL	2.4576 MHz	4.0 MHz	4 9152MHz
	E	614.4 kHz	1.0 MHz	1 2288MHz
0 0	E ÷ 16	26 μs/38,400 Baud	16 μs/62,500 Baud	13 μs/76,800Baud
0 1	E ÷ 128	208μs/4,800 Baud	128 μs/7812.5 Baud	104.2μs/ 9,600Baud
1 0	E ÷ 1024	1.67ms/600 Baud	1.024ms/976.6 Baud	833.3μs/ 1,200Baud
1 1	E ÷ 4096	6.67ms/150 Baud	4.096ms/244.1 Baud	3.333ms/ 300Baud

Table 6 SCI Format and Clock Source Control

CC1: CC0	Format	Clock Source	Port 2 Bit 2	Port 2 Bit 3	Port 2 Bit 4
0 0	-	-	-	-	-
0 1	NRZ	Internal	Not Used***	••	••
1 0	NRZ	Internal	Output*	••	••
1 1	NRZ	External	Input	••	••

* Clock output is available regardless of values for bits RE and TE.
 ** Bit 3 is used for serial input if RE = "1" in TRCS.
 Bit 4 is used for serial output if TE = "1" in TRCS.
 *** This pin can be used as I/O port.

• **Transfer Rate/Mode Control Register (RMCR)**

The register controls the following serial I/O functions:

- Bauds rate
- data format
- clock source
- Port 2 bit 2 feature

It is 4-bit write-only register, cleared by RES. The 4 bits are considered as a pair of 2-bit fields. The lower 2 bits control the bit rate of internal clock while the upper 2 bits control the format and the clock select logic.

Bit 0 SS0 } Speed Select
 Bit 1 SS1 }

These bits select the Baud rate for the internal clock. The rates selectable are function of E clock frequency of the CPU. Table 5 lists the available Baud Rates.

Bit 2 CC0 } Clock Control/Format Select
 Bit 3 CC1 }

They control the data format and the clock select logic. Table 6 defines the bit field.

• **Internally Generated Clock**

If the user wish to use externally an internal clock of the serial I/O, the following requirements should be noted.

- CC1, CC0 must be set to "10".
- The maximum clock rate must be E/16.
- The clock rate is equal to the bit rate.
- The values of RE and TE have no effect.

• **Externally Generated Clock**

If the user wish to supply an external clock to the Serial I/O, the following requirements should be noted.

- The CC1, CC0 must be set to "11" (See Table 6).
- The external clock must be set to 8 times of the desired baud rate.
- The maximum external clock frequency is E/2 clock.

• **Serial Operations**

The serial I/O hardware must be initialized by the software before operation. The sequence will be normally as follows.

- Writing the desired operation control bits of the Rate and Mode Control Register.
- Writing the desired operation control bits of the TRCS register.

If Port 2 bit 3, 4 are used for serial I/O, TE, RE bits may be kept set. When TE, RE bit are cleared during SCI operation, and subsequently set again, it should be noted that TE, RE must be kept "0" for at least one bit time of the current baud rate. If TE, RE are set again within one bit time, there may be the case where the initializing of internal function for transmitter and receiver does not take place correctly.

• **Transmit Operation**

Data transmission is enabled by the TE bit in the TRCS

register. When set, the output of the transmit shift register is connected with Port 2 bit 4 which is unconditionally configured as an output.

After RES, the user should initialize both the RMC register and the TRCS register for desired operation. Setting the TE bit causes a transmission of ten-bit preamble of "1"s. Following the preamble, internal synchronization is established and the transmitter is ready to operate. Then either of the following states exists.

- (1) If the transmit data register is empty (TDRE = 1), the consecutive "1"s are transmitted indicating an idle states.
- (2) If the data has been loaded into the Transmit Data Register (TDRE = 0), it is transferred to the output shift register and data transmission begins.

During the data transfer, the start bit ("0") is first transferred. Next the 8-bit data (beginning at bit 0) and finally the stop bit ("1"). When the contents of the Transmit Data Register is transferred to the output shift register, the hardware sets the TDRE flag bit: If the CPU fails to respond to the flag within the proper time, TDRE is kept set and then a continuous string of 1's is sent until the data is supplied to the data register.

• **Receive Operation**

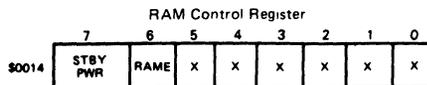
The receive operation is enabled by the RE bit. The serial input is connected with Port 2 bit 3. The receiver operation is determined by the contents of the TRCS and RMC register. The received bit stream is synchronized by the first "0" (start bit). During 10-bit time, the data is strobed approximately at the center of each bit. If the tenth bit is not "1" (stop bit), the system assumes a framing error and the ORFE is set.

If the tenth bit is "1", the data is transferred to the receive data register, and the RDRF flag is set. If the tenth bit of the next data is received and still RDRF is preserved set, then ORFE is set indicating that an overrun error has occurred.

After the CPU read of the status register as a response to RDRF flag or ORFE flag, followed by the CPU read of the receive data register, RDRF or ORFE will be cleared.

■ **RAM CONTROL REGISTER**

The register assigned to the address \$0014 gives a status information about standby RAM.



Bit 0 Not used.
 Bit 1 Not used.
 Bit 2 Not used.

- Bit 3 Not used.**
- Bit 4 Not used.**
- Bit 5 Not used.**
- Bit 6 RAM Enable.**

Using this control bit, the user can disable the RAM. RAM Enable bit is set on the positive edge of RES and RAM is enabled. The program can write "1" or "0". If RAME is cleared, the RAM address becomes external address and the CPU may read the data from the outside memory.

Bit 7 Standby Bit

This bit can be read or written by the user program. It is cleared when the V_{CC} voltage is removed. Normally this bit is set by the program before going into stand-by mode. When the CPU recovers from stand-by mode, this bit should be checked. If it is "1", the data of the RAM is retained during stand-by and it is valid.

■ **GENERAL DESCRIPTION OF INSTRUCTION SET**

The HD6303R has an upward object code compatible with the HD6801 to utilize all instruction sets of the HMCS6800. The execution time of the key instruction is reduced to increase the system through-put. In addition, the bit operation instruction, the exchange instruction between the index and the accumulator, the sleep instruction are added. This section describes:

- CPU programming model (See Fig. 20)
- Addressing modes
- Accumulator and memory manipulation instructions (See Table 7)
- New instructions
- Index register and stack manipulation instructions (See Table 8)
- Jump and branch instructions (See Table 9)
- Condition code register manipulation instructions (See Table 10)
- Op-code map (See Table 11)
- Cycle-by-cycle operation (See Table 12)

● **CPU Programming Model**

The programming model for the HD6303R is shown in Figure 20. The double accumulator is physically the same as the accumulator A concatenated with the accumulator B, so that the contents of A and B is changed with executing operation of an accumulator D.

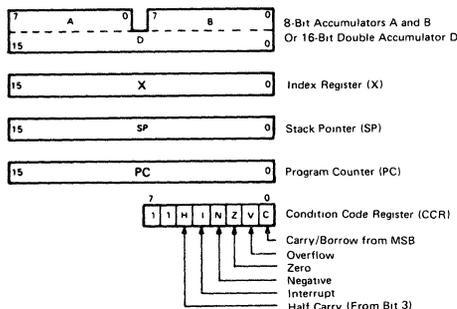


Figure 20 CPU Programming Model

● **CPU Addressing Modes**

The HD6303R has seven address modes which depend on both of the instruction type and the code. The address mode for

every instruction is shown along with execution time given in terms of machine cycles (Table 7 to 11). When the clock frequency is 4 MHz, the machine cycle will be microseconds.

Accumulator (ACCX) Addressing

Only the accumulator (A or B) is addressed. Either accumulator A or B is specified by one-byte instructions.

Immediate Addressing

In this mode, the operand is stored in the second byte of the instruction except that the operand in LDS and LDX, etc are stored in the second and the third byte. These are two or three-byte instructions.

Direct Addressing

In this mode, the second byte of instruction indicates the address where the operand is stored. Direct addressing allows the user to directly address the lowest 256 bytes in the machine; locations zero through 255. Improved execution times are achieved by storing data in these locations. For system configuration, it is recommended that these locations should be RAM and be utilized preferably for user's data realm. These are two-byte instructions except the AIM, OIM, EIM and TIM which have three-byte.

Extended Addressing

In this mode, the second byte indicates the upper 8 bit addresses where the operand is stored, while the third byte indicates the lower 8 bits. This is an absolute address in memory. These are three-byte instructions.

Indexed Addressing

In this mode, the contents of the second byte is added to the lower 8 bits in the Index Register. For each of AIM, OIM, EIM and TIM instructions, the contents of the third byte are added to the lower 8 bits in the Index Register. In addition, the resulting "carry" is added to the upper 8 bits in the Index Register. The result is used for addressing memory. Because the modified address is held in the Temporary Address Register, there is no change to the Index Register. These are two-byte instructions but AIM, OIM, EIM, TIM have three-byte.

Implied Addressing

In this mode, the instruction itself gives the address; stack pointer, index register, etc. These are 1-byte instructions.

Relative Addressing

In this mode, the contents of the second byte is added to the lower 8 bits in the program counter. The resulting carry or borrow is added to the upper 8 bits. This helps the user to address the data within a range of -126 to +129 bytes of the current execution instruction. These are two-byte instructions.

Table 7 Accumulator, Memory Manipulation Instructions

Operations	Mnemonic	Addressing Modes												Boolean/ Arithmetic Operation	Condition Code Register										
		IMMED			DIRECT			INDEX			EXTEND				IMPLIED			5	4	3	2	1	0		
		OP	~	#	OP	~	#	OP	~	#	OP	~	#		OP	~	#	OP	~	#	H	I	N	Z	V
Add	ADDA	8B	2	2	9B	3	2	AB	4	2	BB	4	3						A + M → A	↑	•	↑	↑	↑	↑
	ADDB	CB	2	2	DB	3	2	EB	4	2	FB	4	3						B + M → B	↑	•	↑	↑	↑	↑
Add Double	ADDD	C3	3	3	D3	4	2	E3	5	2	F3	5	3						A · B + M : M + 1 → A · B	•	•	↑	↑	↑	↑
Add Accumulators	ABA													1B	1	1			A + B → A	↑	•	↑	↑	↑	↑
Add With Carry	ADCA	89	2	2	99	3	2	A9	4	2	B9	4	3						A + M + C → A	↑	•	↑	↑	↑	↑
	ADCB	C9	2	2	D9	3	2	E9	4	2	F9	4	3						B + M + C → B	↑	•	↑	↑	↑	↑
AND	ANDA	84	2	2	94	3	2	A4	4	2	B4	4	3						A · M → A	•	•	↑	↑	R	•
	ANDB	C4	2	2	D4	3	2	E4	4	2	F4	4	3						B · M → B	•	•	↑	↑	R	•
Bit Test	BIT A	85	2	2	95	3	2	A5	4	2	B5	4	3						A · M	•	•	↑	↑	R	•
	BIT B	C5	2	2	D5	3	2	E5	4	2	F5	4	3						B · M	•	•	↑	↑	R	•
Clear	CLR							6F	5	2	7F	5	3						00 → M	•	•	R	S	R	R
	CLRA													4F	1	1			00 → A	•	•	R	S	R	R
	CLRB													5F	1	1			00 → B	•	•	R	S	R	R
Compare	CMPA	81	2	2	91	3	2	A1	4	2	B1	4	3						A - M	•	•	↑	↑	↑	↑
	CMPB	C1	2	2	D1	3	2	E1	4	2	F1	4	3						B - M	•	•	↑	↑	↑	↑
Compare Accumulators	CBA													11	1	1			A - B	•	•	↑	↑	↑	↑
Complement, 1's	COM							63	6	2	73	6	3						M → M	•	•	↑	↑	R	S
	COMA													43	1	1			A → A	•	•	↑	↑	R	S
	COMB													53	1	1			B → B	•	•	↑	↑	R	S
Complement, 2's (Negate)	NEG							60	6	2	70	6	3						00 - M → M	•	•	↑	↑	(1)	(2)
	NEGA													40	1	1			00 - A → A	•	•	↑	↑	(1)	(2)
	NEGB													50	1	1			00 - B → B	•	•	↑	↑	(1)	(2)
Decimal Adjust, A	DAA												19	2	1			Converts binary add of BCD characters into BCD format	•	•	↑	↑	↑	(3)	
Decrement	DEC							6A	6	2	7A	6	3						M - 1 → M	•	•	↑	↑	(4)	•
	DECA													4A	1	1			A - 1 → A	•	•	↑	↑	(4)	•
	DECB													5A	1	1			B - 1 → B	•	•	↑	↑	(4)	•
Exclusive OR	EORA	88	2	2	98	3	2	A8	4	2	B8	4	3						A ⊕ M → A	•	•	↑	↑	R	•
	EORB	C8	2	2	D8	3	2	E8	4	2	F8	4	3						B ⊕ M → B	•	•	↑	↑	R	•
Increment	INC							6C	6	2	7C	6	3						M + 1 → M	•	•	↑	↑	(5)	•
	INCA													4C	1	1			A + 1 → A	•	•	↑	↑	(5)	•
	INCB													5C	1	1			B + 1 → B	•	•	↑	↑	(5)	•
Load Accumulator	LDAA	86	2	2	96	3	2	A6	4	2	B6	4	3						M → A	•	•	↑	↑	R	•
	LDAB	C6	2	2	D6	3	2	E6	4	2	F6	4	3						M → B	•	•	↑	↑	R	•
Load Double Accumulator	LDD	CC	3	3	DC	4	2	EC	5	2	FC	5	3						M + 1 → B, M → A	•	•	↑	↑	R	•
Multiply Unsigned	MUL													3D	7	1			A × B → A : B	•	•	•	•	(1)	
OR, Inclusive	ORAA	8A	2	2	9A	3	2	AA	4	2	BA	4	3						A + M → A	•	•	↑	↑	R	•
	ORAB	CA	2	2	DA	3	2	EA	4	2	FA	4	3						B + M → B	•	•	↑	↑	R	•
Push Data	PSHA													36	4	1			A → Msp, SP - 1 → SP	•	•	•	•	•	•
	PSHB													37	4	1			B → Msp, SP - 1 → SP	•	•	•	•	•	•
Pull Data	PULA													32	3	1			SP + 1 → SP, Msp → A	•	•	•	•	•	•
	PULB													33	3	1			SP + 1 → SP, Msp → B	•	•	•	•	•	•
Rotate Left	ROL							69	6	2	79	6	3						M	•	•	↑	↑	(6)	↑
	ROLA													49	1	1			A	•	•	↑	↑	(6)	↑
	ROLB													59	1	1			B	•	•	↑	↑	(6)	↑
Rotate Right	ROR							66	6	2	76	6	3						M	•	•	↑	↑	(6)	↑
	RORA													46	1	1			A	•	•	↑	↑	(6)	↑
	RORB													56	1	1			B	•	•	↑	↑	(6)	↑

Note) Condition Code Register will be explained in Note of Table 10.

(to be continued)

Table 7 Accumulator, Memory Manipulation Instructions

Operations	Mnemonic	Addressing Modes												Boolean/ Arithmetic Operation	Condition Code Register									
		IMMED			DIRECT			INDEX			EXTEND				IMPLIED			5	4	3	2	1	0	
		OP	~	#	OP	~	#	OP	~	#	OP	~	#		OP	~	#	H	I	N	Z	V	C	
Shift Left Arithmetic	ASL							68	6	2	78	6	3			•	•	↑	↑	Ⓠ	↑			
	ASLA												48	1	1	A		•	•	↑	↑	Ⓠ	↑	
	ASLB													58	1	1	B		•	•	↑	↑	Ⓠ	↑
Double Shift Left, Arithmetic	ASLD													05	1	1	A		•	•	↑	↑	Ⓠ	↑
Shift Right Arithmetic	ASR							67	6	2	77	6	3			•	•	↑	↑	Ⓠ	↑			
	ASRA												47	1	1	A		•	•	↑	↑	Ⓠ	↑	
	ASRB													57	1	1	B		•	•	↑	↑	Ⓠ	↑
Shift Right Logical	LSR							64	6	2	74	6	3			•	•	R	↑	Ⓠ	↑			
	LSRA												44	1	1	A		•	•	R	↑	Ⓠ	↑	
	LSRB													54	1	1	B		•	•	R	↑	Ⓠ	↑
Double Shift Right Logical	LSRD													04	1	1	A		•	•	R	↑	Ⓠ	↑
Store Accumulator	STAA				97	3	2	A7	4	2	B7	4	3		A → M	•	•	↑	↑	R	•			
	STAB				D7	3	2	E7	4	2	F7	4	3		B → M	•	•	↑	↑	R	•			
Store Double Accumulator	STD				DD	4	2	ED	5	2	FD	5	3		A → M B → M + 1	•	•	↑	↑	R	•			
Subtract	SUBA	80	2	2	90	3	2	A0	4	2	B0	4	3		A - M → A	•	•	↑	↑	↑	↑			
	SUBB	C0	2	2	D0	3	2	E0	4	2	F0	4	3		B - M → B	•	•	↑	↑	↑	↑			
Double Subtract	SUBD	83	3	3	93	4	2	A3	5	2	B3	5	3		A : B - M : M + 1 → A : B	•	•	↑	↑	↑	↑			
Subtract Accumulators	SBA													10	1	1		A - B → A	•	•	↑	↑	↑	↑
Subtract With Carry	SBCA	82	2	2	92	3	2	A2	4	2	B2	4	3		A - M - C → A	•	•	↑	↑	↑	↑			
	SBCB	C2	2	2	D2	3	2	E2	4	2	F2	4	3		B - M - C → B	•	•	↑	↑	↑	↑			
Transfer Accumulators	TAB													16	1	1		A → B	•	•	↑	↑	R	•
	TBA													17	1	1		B → A	•	•	↑	↑	R	•
Test Zero or Minus	TST							6D	4	2	7D	4	3		M - 00	•	•	↑	↑	R	R			
	TSTA													4D	1	1	A	A - 00	•	•	↑	↑	R	R
	TSTB													5D	1	1	B	B - 00	•	•	↑	↑	R	R
And Immediate	AIM				71	6	3	61	7	3								M-IMM → M	•	•	↑	↑	R	•
OR Immediate	OIM				72	6	3	62	7	3								M+IMM → M	•	•	↑	↑	R	•
EOR Immediate	EIM				75	6	3	65	7	3								M⊕IMM → M	•	•	↑	↑	R	•
Test Immediate	TIM				7B	4	3	6B	5	3								M-IMM	•	•	↑	↑	R	•

Note) Condition Code Register will be explained in Note of Table 10.

● New Instructions

In addition to the HD6801 Instruction Set, the HD6303R has the following new instructions:

AIM----(M) · (IMM) → (M)

Evaluates the AND of the immediate data and the memory, places the result in the memory.

OIM----(M) + (IMM) → (M)

Evaluates the OR of the immediate data and the memory, places the result in the memory.

EIM----(M) ⊕ (IMM) → (M)

Evaluates the EOR of the immediate data and the contents of memory, places the result in memory.

TIM----(M) · (IMM)

Evaluates the AND of the immediate data and the memory, changes the flag of associated condition code register

Each instruction has three bytes; the first is op-code, the second is immediate data, the third is address modifier.

XGDX--(ACCD) ↔ (IX)

Exchanges the contents of accumulator and the index register.

SLP----The MPU is brought to the sleep mode. For sleep mode, see the "sleep mode" section.

Table 8 Index Register, Stack Manipulation Instructions

Pointer Operations	Mnemonic	Addressing Modes										Boolean/ Arithmetic Operation	Condition Code Register					
		IMMED.		DIRECT		INDEX		EXTEND		IMPLIED			5	4	3	2	1	0
		OP	~ #	OP	~ #	OP	~ #	OP	~ #	OP	~ #		H	I	N	Z	V	C
Compare Index Reg	CPX	8C	3 3	9C	4 2	AC	5 2	BC	5 3			X - M + 1						
Decrement Index Reg	DEX									09	1 1	X - 1 → X	•	•	•	•	•	
Decrement Stack Pntr	DES									34	1 1	SP - 1 → SP	•	•	•	•	•	
Increment Index Reg	INX									08	1 1	X + 1 → X	•	•	•	•	•	
Increment Stack Pntr	INS									31	1 1	SP + 1 → SP	•	•	•	•	•	
Load Index Reg	LDX	CE	3 3	DE	4 2	EE	5 2	FE	5 3			M → X _H , (M + 1) → X _L	•	•	⊕	•	•	
Load Stack Pntr	LDS	8E	3 3	9E	4 2	AE	5 2	BE	5 3			M → SP _H , (M + 1) → SP _L	•	•	⊕	•	•	
Store Index Reg	STX			DF	4 2	EF	5 2	FF	5 3			X _H → M, X _L → (M + 1)	•	•	⊕	•	•	
Store Stack Pntr	STS			9F	4 2	AF	5 2	BF	5 3			SP _H → M, SP _L → (M + 1)	•	•	⊕	•	•	
Index Reg → Stack Pntr	TXS									35	1 1	X - 1 → SP	•	•	•	•	•	
Stack Pntr → Index Reg	TSX									30	1 1	SP + 1 → X	•	•	•	•	•	
Add	ABX									3A	1 1	B + X → X	•	•	•	•	•	
Push Data	PSHX									3C	5 1	X _L → M _{sp} , SP - 1 → SP X _H → M _{sp} , SP - 1 → SP	•	•	•	•	•	
Pull Data	PULX									38	4 1	SP + 1 → SP, M _{sp} → X _H SP + 1 → SP, M _{sp} → X _L	•	•	•	•	•	
Exchange	X GDX									18	2 1	ACCD → IX	•	•	•	•	•	

Note) Condition Code Register will be explained in Note of Table 10.

Table 9 Jump, Branch Instruction

Operations	Mnemonic	Addressing Modes										Branch Test	Condition Code Register					
		RELATIVE		DIRECT		INDEX		EXTEND		IMPLIED			5	4	3	2	1	0
		OP	~ #	OP	~ #	OP	~ #	OP	~ #	OP	~ #		H	I	N	Z	V	C
Branch Always	BRA	20	3 2									None	•	•	•	•	•	
Branch Never	BRN	21	3 2									None	•	•	•	•	•	
Branch If Carry Clear	BCC	24	3 2									C = 0	•	•	•	•	•	
Branch If Carry Set	BCS	25	3 2									C = 1	•	•	•	•	•	
Branch If = Zero	BEQ	27	3 2									Z = 1	•	•	•	•	•	
Branch If > Zero	BGE	2C	3 2									N ⊕ V = 0	•	•	•	•	•	
Branch If > Zero	BGT	2E	3 2									Z + (N ⊕ V) = 0	•	•	•	•	•	
Branch If Higher	BHI	22	3 2									C + Z = 0	•	•	•	•	•	
Branch If < Zero	BLE	2F	3 2									Z + (N ⊕ V) = 1	•	•	•	•	•	
Branch If Lower Or Same	BLS	23	3 2									C + Z = 1	•	•	•	•	•	
Branch If < Zero	BLT	2D	3 2									N ⊕ V = 1	•	•	•	•	•	
Branch If Minus	BMI	2B	3 2									N = 1	•	•	•	•	•	
Branch If Not Equal Zero	BNE	26	3 2									Z = 0	•	•	•	•	•	
Branch If Overflow Clear	BVC	28	3 2									V = 0	•	•	•	•	•	
Branch If Overflow Set	BVS	29	3 2									V = 1	•	•	•	•	•	
Branch If Plus	BPL	2A	3 2									N = 0	•	•	•	•	•	
Branch To Subroutine	BSR	8D	5 2										•	•	•	•	•	
Jump	JMP					6E	3 2	7E	3 3				•	•	•	•	•	
Jump To Subroutine	JSR			9D	5 2	AD	5 2	BD	6 3				•	•	•	•	•	
No Operation	NOP									01	1 1	Advances Prog. Cntr. Only	•	•	•	•	•	
Return From Interrupt	RTI									3B	10 1		•	•	•	•	•	
Return From Subroutine	RTS									39	5 1		•	•	•	•	•	
Software Interrupt	SWI									3F	12 1		•	S	•	•	•	
Wait for Interrupt*	WAI									3E	9 1		•	Ⓣ	•	•	•	
Sleep	SLP									1A	4 1		•	•	•	•	•	

Note) *WAI puts R/W high; Address Bus goes to FFFF; Data Bus goes to the three state. Condition Code Register will be explained in Note of Table 10.

Table 10 Condition Code Register Manipulation Instructions

Operations	Mnemonic	Addressing Modes			Boolean Operation	Condition Code Register										
		IMPLIED				5	4	3	2	1	0					
		OP	~	#												
Clear Carry	CLC	0C	1	1	0 → C	•	•	•	•	•	•	•	•	•	•	
Clear Interrupt Mask	CLI	0E	1	1	0 → I	•	R	•	•	•	•	•	•	•	•	
Clear Overflow	CLV	0A	1	1	0 → V	•	•	•	•	•	R	•	•	•	•	
Set Carry	SEC	0D	1	1	1 → C	•	•	•	•	•	•	•	S	•	•	
Set Interrupt Mask	SEI	0F	1	1	1 → I	•	S	•	•	•	•	•	•	•	•	
Set Overflow	SEV	0B	1	1	1 → V	•	•	•	•	•	•	•	•	•	•	
Accumulator A → CCR	TAP	06	1	1	A → CCR	10						•	•	•	•	•
CCR → Accumulator A	TPA	07	1	1	CCR → A	•	•	•	•	•	•	•	•	•	•	

(NOTE 1) Condition Code Register Notes: (Bit set if test is true and cleared otherwise)

- ① (Bit V) Test: Result = 10000000?
- ② (Bit C) Test: Result ≠ 00000000?
- ③ (Bit C) Test: BCD Character of high-order byte greater than 9? (Not cleared if previously set)
- ④ (Bit V) Test: Operand = 10000000 prior to execution?
- ⑤ (Bit V) Test: Operand = 01111111 prior to execution?
- ⑥ (Bit V) Test: Set equal to N⊕C=1 after the execution of instructions
- ⑦ (Bit N) Test: Result less than zero? (Bit 15=1)
- ⑧ (All Bit) Load Condition Code Register from Stack.
- ⑨ (Bit I) Set when interrupt occurs. If previously set, a Non-Maskable Interrupt is required to exit the wait state.
- ⑩ (All Bit) Set according to the contents of Accumulator A.
- ⑪ (Bit C) Result of Multiplication Bit 7=1 of ACCB?

(NOTE 2) CLI instruction and interrupt.

If interrupt mask-bit is set (I="1") and interrupt is requested ($\overline{IRQ}_1 = "0"$ or $\overline{IRQ}_2 = "0"$), and then CLI instruction is executed, the CPU responds as follows.

- ① The next instruction of CLI is one-machine cycle instruction. Subsequent two instructions are executed before the interrupt is responded. That is, the next and the next of the next instruction are executed.
- ② The next instruction of CLI is two-machine cycle (or more) instruction. Only the next instruction is executed and then the CPU jump to the interrupt routine. Even if TAP instruction is used, instead of CLI, the same thing occurs.

Table 11 OP-Code Map

OP CODE					ACC			EXT DIR	ACCA or SP				ACCB or X				
	HI	0000	0001	0010	0011	0100	0101		0110	0111	1000	1001	1010	1011	1100	1101	1110
LO	0	1	2	3	4	5	6	7	8	9	A	B	C	D	E	F	
0000	0	SBA	BRA	TSX	NEG				SUB								0
0001	1	NOP	CBA	BRN	INS	AIM			CMP								1
0010	2		BHI	PULA	OIM			SBC									2
0011	3		BLS	PULB	COM			SUBD				ADD				3	
0100	4	LSRD		BCC	DES	LSR			AND								4
0101	5	ASLD		BCS	TXS	EIM			BIT								5
0110	6	TAP	TAB	BNE	PSHA	ROR			LDA				STA				6
0111	7	TPA	TBA	BEQ	PSHB	ASR			STA				STA				7
1000	8	INX	XGDX	BVC	PULX	ASL			EOR								8
1001	9	DEX	DAA	BVS	RTS	ROL			ADC								9
1010	A	CLV	SLP	BPL	ABX	DEC			ORA								A
1011	B	SEV	ABA	BMI	RTI	TIM			ADD								B
1100	C	CLC		BGE	PSHX	INC			CPX				LDD				C
1101	D	SEC		BLT	MUL	TST			BSR		JSR		STD				D
1110	E	CLI		BGT	WAI	JMP			LDS		LDX						E
1111	F	SEI		BLE	SWI	CLR			STS				STX				F

UNDEFINED OP CODE * Only for instructions of AIM, OIM, EIM, TIM

● **Instruction Execution Cycles**

In the HMCS6800 series, the execution cycle of each instruction is the number of cycles between the start of the current instruction fetch and just before the start of the subsequent instruction fetch.

The HD6303R uses a mechanism of the pipeline control for the instruction fetch and the subsequent instruction fetch is performed during the current instruction being executed.

Therefore, the method to count instruction cycles used in the HMCS6800 series cannot be applied to the instruction cycles such as MULT, PULL, DAA and XGD_X in the HD6303R.

Table 12 provides the information about the relationship among each data on the Address Bus, Data Bus, and R/W status in cycle-by-cycle basis during the execution of each instruction.

Table 12 Cycle-by-Cycle Operation

Address Mode & Instructions	Cycles	Cycle #	Address Bus	R/W	Data Bus
IMMEDIATE					
ADC ADD	2	1	Op Code Address+1	1	Operand Data
AND BIT		2	Op Code Address+2	1	Next Op Code
CMP EOR					
LDA ORA					
SBC SUB					
ADDD CPX	3	1	Op Code Address+1	1	Operand Data (MSB)
LDD LDS		2	Op Code Address+2	1	Operand Data (LSB)
LDX SUBD		3	Op Code Address+3	1	Next Op Code
DIRECT					
ADC ADD	3	1	Op Code Address+1	1	Address of Operand (LSB)
AND BIT		2	Address of Operand	1	Operand Data
CMP EOR		3	Op Code Address+2	1	Next Op Code
LDA ORA					
SBC SUB					
STA	3	1	Op Code Address+1	1	Destination Address
		2	Destination Address	0	Accumulator Data
		3	Op Code Address+2	1	Next Op Code
ADDD CPX	4	1	Op Code Address+1	1	Address of Operand (LSB)
LDD LDS		2	Address of Operand	1	Operand Data (MSB)
LDX SUBD		3	Address of Operand+1	1	Operand Data (LSB)
		4	Op Code Address+2	1	Next Op Code
STD STS	4	1	Op Code Address+1	1	Destination Address (LSB)
STX		2	Destination Address	0	Register Data (MSB)
		3	Destination Address+1	0	Register Data (LSB)
		4	Op Code Address+2	1	Next Op Code
JSR	5	1	Op Code Address+1	1	Jump Address (LSB)
		2	FFFF	1	Restart Address (LSB)
		3	Stack Pointer	0	Return Address (LSB)
		4	Stack Pointer-1	0	Return Address (MSB)
		5	Jump Address	1	First Subroutine Op Code
TIM	4	1	Op Code Address+1	1	Immediate Data
		2	Op Code Address+2	1	Address of Operand (LSB)
		3	Address of Operand	1	Operand Data
		4	Op Code Address+3	1	Next Op Code
AIM EIM	6	1	Op Code Address+1	1	Immediate Data
OIM		2	Op Code Address+2	1	Address of Operand (LSB)
		3	Address of Operand	1	Operand Data
		4	FFFF	1	Restart Address (LSB)
		5	Address of Operand	0	New Operand Data
		6	Op Code Address+3	1	Next Op Code

— Continued —

Table 12 Cycle-by-Cycle Operation (Continued)

Address Mode & Instructions	Cycles	Cycle #	Address Bus	R/W	Data Bus
INDEXED					
JMP	3	1	Op Code Address+1	1	Offset
		2	FFFF	1	Restart Address (LSB)
		3	Jump Address	1	First Op Code of Jump Routine
ADC ADD	4	1	Op Code Address+1	1	Offset
AND BIT		2	FFFF	1	Restart Address (LSB)
CMP EOR		3	IX+Offset	1	Operand Data
LDA ORA		4	Op Code Address+2	1	Next Op Code
SBC SUB					
STA	4	1	Op Code Address+1	1	Offset
		2	FFFF	1	Restart Address (LSB)
		3	IX+Offset	0	Accumulator Data
		4	Op Code Address+2	1	Next Op Code
ADDD	5	1	Op Code Address+1	1	Offset
CPX LDD		2	FFFF	1	Restart Address (LSB)
LDS LDX		3	IX+Offset	1	Operand Data (MSB)
SUBD		4	IX+Offset+1	1	Operand Data (LSB)
		5	Op Code Address+2	1	Next Op Code
STD STS	5	1	Op Code Address+1	1	Offset
STX		2	FFFF	1	Restart Address (LSB)
		3	IX+Offset	0	Register Data (MSB)
		4	IX+Offset+1	0	Register Data (LSB)
		5	Op Code Address+2	1	Next Op Code
JSR	5	1	Op Code Address+1	1	Offset
		2	FFFF	1	Restart Address (LSB)
		3	Stack Pointer	0	Return Address (LSB)
		4	Stack Pointer-1	0	Return Address (MSB)
		5	IX+Offset	1	First Subroutine Op Code
ASL ASR	6	1	Op Code Address+1	1	Offset
COM DEC		2	FFFF	1	Restart Address (LSB)
INC LSR		3	IX+Offset	1	Operand Data
NEG ROL		4	FFFF	1	Restart Address (LSB)
ROR		5	IX+Offset	0	New Operand Data
		6	Op Code Address+1	1	Next Op Code
TIM	5	1	Op Code Address+1	1	Immediate Data
		2	Op Code Address+2	1	Offset
		3	FFFF	1	Restart Address (LSB)
		4	IX+Offset	1	Operand Data
		5	Op Code Address+3	1	Next Op Code
CLR	5	1	Op Code Address+1	1	Offset
		2	FFFF	1	Restart Address (LSB)
		3	IX+Offset	1	Operand Data
		4	IX+Offset	0	00
		5	Op Code Address+2	1	Next Op Code
AIM EIM	7	1	Op Code Address+1	1	Immediate Data
OIM		2	Op Code Address+2	1	Offset
		3	FFFF	1	Restart Address (LSB)
		4	IX+Offset	1	Operand Data
		5	FFFF	1	Restart Address (LSB)
		6	IX+Offset	0	New Operand Data
		7	Op Code Address+3	1	Next Op Code

- Continued -

Table 12 Cycle-by-Cycle Operation (Continued)

Address Mode & Instructions	Cycles	Cycle #	Address Bus	R/W	Data Bus
EXTEND					
JMP	3	1	Op Code Address+1	1	Jump Address (MSB)
		2	Op Code Address+2	1	Jump Address (LSB)
		3	Jump Address	1	Next Op Code
ADC ADD TST AND BIT CMP EOR LDA ORA SBC SUB	4	1	Op Code Address+1	1	Address of Operand (MSB)
		2	Op Code Address+2	1	Address of Operand (LSB)
		3	Address of Operand	1	Operand Data
		4	Op Code Address+3	1	Next Op Code
STA	4	1	Op Code Address+1	1	Destination Address (MSB)
		2	Op Code Address+2	1	Destination Address (LSB)
		3	Destination Address	0	Accumulator Data
		4	Op Code Address+3	1	Next Op Code
ADDD CPX LDD LDS LDX SUBD	5	1	Op Code Address+1	1	Address of Operand (MSB)
		2	Op Code Address+2	1	Address of Operand (LSB)
		3	Address of Operand	1	Operand Data (MSB)
		4	Address of Operand+1	1	Operand Data (LSB)
		5	Op Code Address+3	1	Next Op Code
STD STS STX	5	1	Op Code Address+1	1	Destination Address (MSB)
		2	Op Code Address+2	1	Destination Address (LSB)
		3	Destination Address	0	Register Data (MSB)
		4	Destination Address+1	0	Register Data (LSB)
JSR	6	5	Op Code Address+3	1	Next Op Code
		1	Op Code Address+1	1	Jump Address (MSB)
		2	Op Code Address+2	1	Jump Address (LSB)
		3	FFFF	1	Restart Address (LSB)
		4	Stack Pointer	0	Return Address (LSB)
		5	Stack Pointer-1	0	Return Address (MSB)
ASL ASR COM DEC INC LSR NEG ROL ROR	6	6	Jump Address	1	First Subroutine Op Code
		1	Op Code Address+1	1	Address of Operand (MSB)
		2	Op Code Address+2	1	Address of Operand (LSB)
		3	Address of Operand	1	Operand Data
		4	FFFF	1	Restart Address (LSB)
		5	Address of Operand	0	New Operand Data
CLR	5	6	Op Code Address+3	1	Next Op Code
		1	Op Code Address+1	1	Address of Operand (MSB)
		2	Op Code Address+2	1	Address of Operand (LSB)
		3	Address of Operand	1	Operand Data
		4	Address of Operand	0	00
5	Op Code Address+3	1	Next Op Code		

- Continued -

Table 12 Cycle-by-Cycle Operation (Continued)

Address Mode & Instructions		Cycles	Cycle #	Address Bus	R/W	Data Bus
IMPLIED						
ABA	ABX		1	Op Code Address+1	1	Next Op Code
ASL	ASLD					
ASR	CBA					
CLC	CLI					
CLR	CLV					
COM	DEC					
DES	DEX					
INC	INS					
INX	LSR	1				
LSRD	ROL					
ROR	NOP					
SBA	SEC					
SEI	SEV					
TAB	TAP					
TBA	TPA					
TST	TSX					
TXS						
DAA	XGDX	2	1	Op Code Address+1	1	Next Op Code
			2	FFFF	1	Restart Address (LSB)
PULA	PULB	3	1	Op Code Address+1	1	Next Op Code
			2	FFFF	1	Restart Address (LSB)
			3	Stack Pointer+1	1	Data from Stack
PSHA	PSHB	4	1	Op Code Address+1	1	Next Op Code
			2	FFFF	1	Restart Address (LSB)
			3	Stack Pointer	0	Accumulator Data
			4	Op Code Address+1	1	Next Op Code
PULX		4	1	Op Code Address+1	1	Next Op Code
			2	FFFF	1	Restart Address (LSB)
			3	Stack Pointer+1	1	Data from Stack (MSB)
			4	Stack Pointer+2	1	Data from Stack (LSB)
PSHX		5	1	Op Code Address+1	1	Next Op Code
			2	FFFF	1	Restart Address (LSB)
			3	Stack Pointer	0	Index Register (LSB)
			4	Stack Pointer-1	0	Index Register (MSB)
			5	Op Code Address+1	1	Next Op Code
RTS		5	1	Op Code Address+1	1	Next Op Code
			2	FFFF	1	Restart Address (LSB)
			3	Stack Pointer+1	1	Return Address (MSB)
			4	Stack Pointer+2	1	Return Address (LSB)
			5	Return Address	1	First Op Code of Return Routine
MUL		7	1	Op Code Address+1	1	Next Op Code
			2	FFFF	1	Restart Address (LSB)
			3	FFFF	1	Restart Address (LSB)
			4	FFFF	1	Restart Address (LSB)
			5	FFFF	1	Restart Address (LSB)
			6	FFFF	1	Restart Address (LSB)
			7	FFFF	1	Restart Address (LSB)

- Continued -

Table 12 Cycle-by-Cycle Operation (Continued)

Address Mode & Instructions	Cycles	Cycle #	Address Bus	R/W	Data Bus
IMPLIED					
WAI	9	1	Op Code Address + 1	1	Next Op Code
		2	FFFF	1	Restart Address (LSB)
		3	Stack Pointer	0	Return Address (LSB)
		4	Stack Pointer - 1	0	Return Address (MSB)
		5	Stack Pointer - 2	0	Index Register (LSB)
		6	Stack Pointer - 3	0	Index Register (MSB)
		7	Stack Pointer - 4	0	Accumulator A
		8	Stack Pointer - 5	0	Accumulator B
		9	Stack Pointer - 6	0	Conditional Code Register
RTI	10	1	Op Code Address + 1	1	Next Op Code
		2	FFFF	1	Restart Address (LSB)
		3	Stack Pointer	1	Conditional Code Register
		4	Stack Pointer + 1	1	Accumulator B
		5	Stack Pointer + 2	1	Accumulator A
		6	Stack Pointer + 3	1	Index Register (MSB)
		7	Stack Pointer + 4	1	Index Register (LSB)
		8	Stack Pointer + 5	1	Return Address (MSB)
		9	Stack Pointer + 6	1	Return Address (LSB)
		10	Return Address	1	First Op Code of Return Routine
SWI	12	1	Op Code Address + 1	1	Next Op Code
		2	FFFF	1	Restart Address (LSB)
		3	Stack Pointer	0	Return Address (LSB)
		4	Stack Pointer - 1	0	Return Address (MSB)
		5	Stack Pointer - 2	0	Index Register (LSB)
		6	Stack Pointer - 3	0	Index Register (MSB)
		7	Stack Pointer - 4	0	Accumulator A
		8	Stack Pointer - 5	0	Accumulator B
		9	Stack Pointer - 6	0	Conditional Code Register
		10	Vector Address FFFA	1	Address of SWI Routine (MSB)
		11	Vector Address FFFB	1	Address of SWI Routine (LSB)
		12	Address of SWI Routine	1	First Op Code of SWI Routine
SLP	4	1	Op Code Address + 1	1	Next Op Code
		2	FFFF	1	Restart Address (LSB)
		Sleep			High Impedance-Non MPX Mode Address Bus -MPX Mode
		3	FFFF		Restart Address (LSB)
		4	Op Code Address + 1		Next Op Code

- Continued -

Table 12 Cycle-by-Cycle Operation (Continued)

Address Mode & Instructions	Cycles	Cycle #	Address Bus	R/W	Data Bus	
RELATIVE						
BCC BCS	3	1	Op Code Address+1	1	Branch Offset	
BEQ BGE		2	FFFF	1	Restart Address (LSB)	
BGT BHI		3	3	{ Branch Address.....Test="1" { Op Code Address+1...Test="0"	1	First Op Code of Branch Routine Next Op Code
BLE BLS						
BLT BMT		5	1	Op Code Address+1	1	Offset
BNE BPL			2	FFFF	1	Restart Address (LSB)
BRA BRN			3	Stack Pointer	0	Return Address (LSB)
BVC BVS	4		Stack Pointer-1	0	Return Address (MSB)	
BSR	5		Branch Address	1	First Op Code of Subroutine	

■ **LOW POWER CONSUMPTION MODE**

The HD6303R has two low power consumption modes; sleep and standby mode.

● **Sleep Mode**

On execution of SLP instruction, the MPU is brought to the sleep mode. In the sleep mode, the CPU sleeps (the CPU clock becomes inactive), but the contents of the registers in the CPU are retained. In this mode, the peripherals of CPU will remain active. So the operations such as transmit and receive of the SCI data and counter may keep in operation. In this mode, the power consumption is reduced to about 1/6 the value of a normal operation.

The escape from this mode can be done by interrupt, $\overline{\text{RES}}$, $\overline{\text{STBY}}$. The $\overline{\text{RES}}$ resets the MPU and the $\overline{\text{STBY}}$ brings it into the standby mode (This will be mentioned later). When interrupt is requested to the CPU and accepted, the sleep mode is released, then the CPU is brought in the operation mode and jumps to the interrupt routine. When the CPU has masked the interrupt, after recovering from the sleep mode, the next instruction of SLP starts to execute. However, in such a case that the timer interrupt is inhibited on the timer side, the sleep mode cannot be released due to the absence of the interrupt request to the CPU.

This sleep mode is available to reduce an average power consumption in the applications of the HD6303R which may not be always running.

● **Standby Mode**

Bringing $\overline{\text{STBY}}$ "Low", the CPU becomes reset and all clocks of the HD6303R become inactive. It goes into the standby mode. This mode remarkably reduces the power consumptions of the HD6303R.

In the standby mode, if the HD6303R is continuously supplied with power, the contents of RAM is retained. The standby mode should escape by the reset start. The following is the typical application of this mode.

First, $\overline{\text{NMI}}$ routine stacks the CPU's internal information and the contents of SP in RAM, disables RAME bit of RAM control register, sets the standby bit, and then goes into the standby mode. If the standby bit keeps set on reset start, it means that the power has been kept during stand-by mode and the contents of RAM is normally guaranteed. The system recovery may be possible by returning SP and bringing into the condition before the standby mode has started. The timing relation for each line in this application is shown in Figure 21.

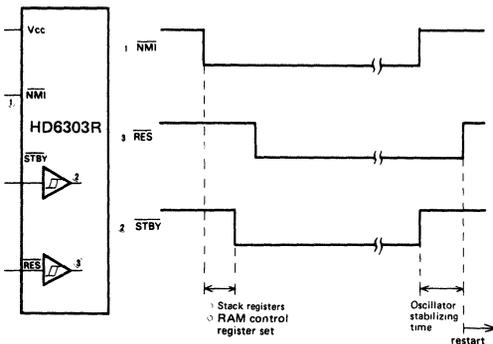


Figure 21 Standby Mode Timing

■ **ERROR PROCESSING**

When the HD6303R fetches an undefined instruction or fetches an instruction from unusable memory area, it generates the highest priority internal interrupt, that may protect from system upset due to noise or a program error.

● **Op-Code Error**

Fetching an undefined op-code, the HD6303R will stack the CPU register as in the case of a normal interrupt and vector to the TRAP (\$FFEE, \$FFEF), that has a second highest priority (RES is the highest).

● **Address Error**

When an instruction is fetched from other than a resident RAM, or an external memory area, the CPU starts the same interrupt as op-code error. In the case which the instruction is fetched from external memory area and that area is not usable, the address error can not be detected.

The address which cause address error are shown in Table 13.

This feature is applicable only to the instruction fetch, not to normal read/write of data accessing.

Transitions among the active mode, sleep mode, standby mode and reset are shown in Figure 22.

Figures 23, 24 show a system configuration.

The system flow chart of HD6303R is shown in Figure 25.

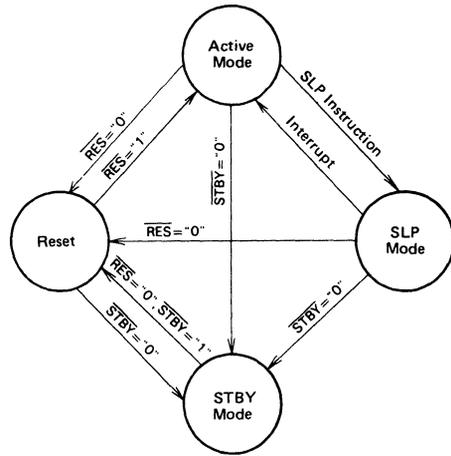


Figure 22 Transitions among Active Mode, Standby Mode, Sleep Mode, and Reset

Table 13 Address Error

Address Error
\$0000 ~ \$001F

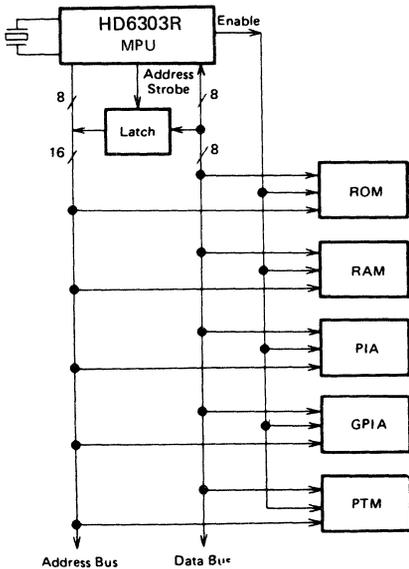


Figure 23 HD6303R MPU Multiplexed Mode

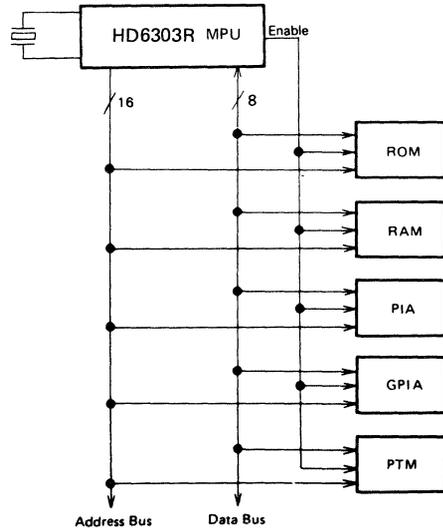


Figure 24 HD6303R MPU Non-Multiplexed Mode

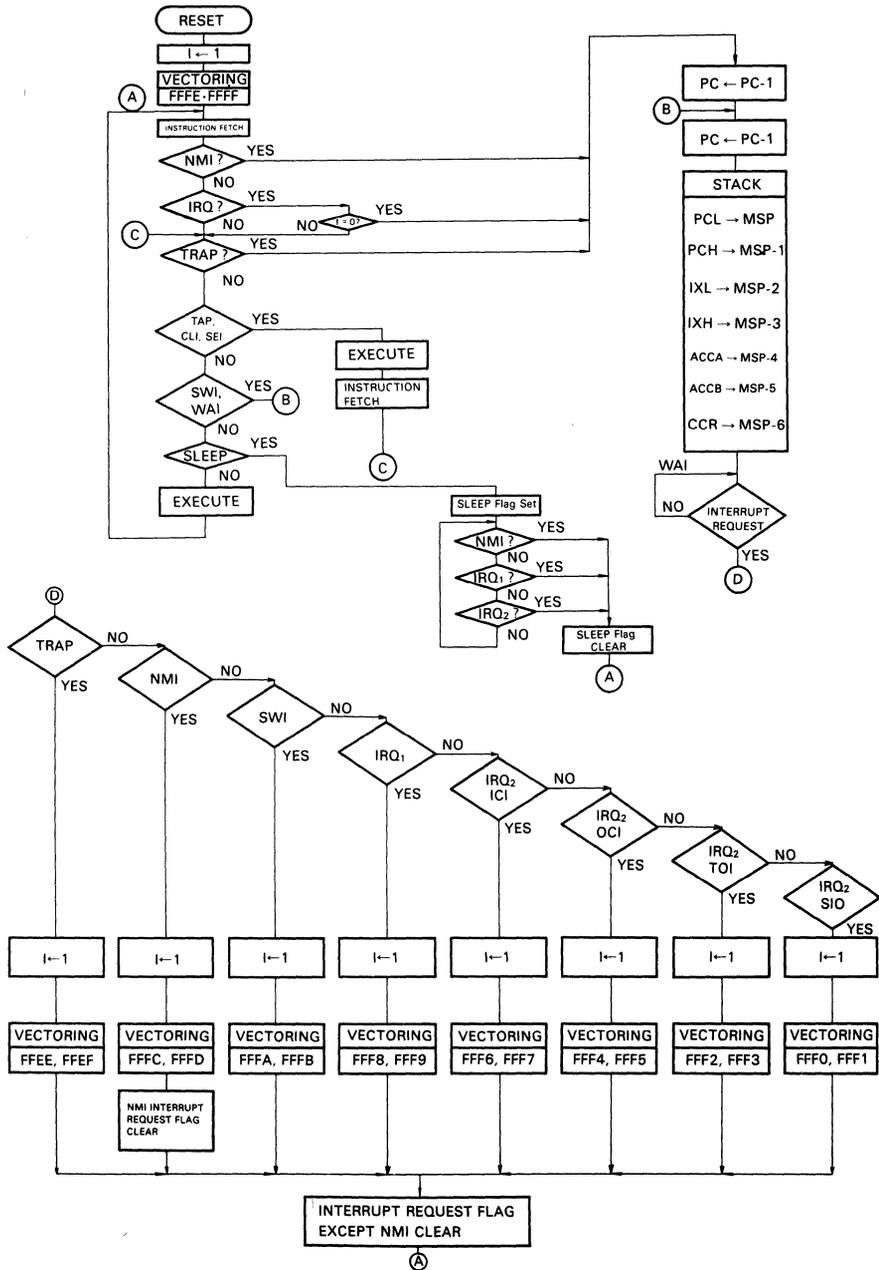
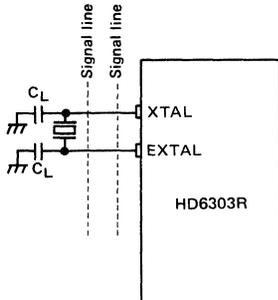


Figure 25 HD6303R System Flow Chart

■ PRECAUTION TO THE BOARD DESIGN OF OSCILLATION CIRCUIT

As shown in Fig. 26, there is a case that the cross talk disturbs the normal oscillation if signal lines are put near the oscillation circuit. When designing a board, pay attention to this. Crystal and C_L must be put as near the HD6303R as possible.



Do not use this kind of print board design.

Figure 26 Precaution to the board design of oscillation circuit

■ PIN CONDITIONS AT SLEEP AND STANDBY STATE

● Sleep State

The conditions of power supply pins, clock pins, input pins and E clock pin are the same as those of operation. Refer to Table 14 for the other pin conditions.

● Standby State

Only power supply pins and \overline{STBY} are active. As for the clock pin EXTAL, its input is fixed internally so the MPU is not influenced by the pin conditions. XTAL is in "1" output. All the other pins are in high impedance.

Table 14 Pin Condition in Sleep State

Pin \ Mode		Non Multiplexed Mode	Multiplexed Mode
P ₂₀ ~ P ₂₄	Function	I/O Port	I/O Port
	Condition	Keep the condition just before sleep	←
A ₀ /P ₁₀ ~ A ₇ /P ₁₇	Function	Address Bus (A ₀ ~ A ₇)	I/O Port
	Condition	Output "1"	Keep the condition just before sleep
A ₈ ~ A ₁₅	Function	Address Bus (A ₈ ~ A ₁₅)	Address Bus (A ₈ ~ A ₁₅)
	Condition	Output "1"	←
D ₀ /A ₀ ~ D ₇ /A ₇	Function	Data Bus (D ₀ ~ D ₇)	\overline{E} : Address Bus (A ₀ ~ A ₇), E: Data Bus
	Condition	High Impedance	\overline{E} : Output "1", E: High Impedance
R/ \overline{W}	Function	R/ \overline{W} Signal	R/ \overline{W} Signal
	Condition	Output "1"	←
AS		—	Output AS

Table 15 Pin Condition during RESET

Pin \ Mode		Non-Multiplexed Mode	Multiplexed Mode
P ₂₀ ~ P ₂₄		High Impedance	←
A ₀ /P ₁₀ ~ A ₇ /P ₁₇		High Impedance	←
A ₈ ~ A ₁₅		High Impedance	←
D ₀ /A ₀ ~ D ₇ /A ₇		High Impedance	E: "1" Output E: High Impedance
R/ \overline{W}		"1" Output	←
AS		\overline{E} : "1" Output E: "0" Output	←

■ **DIFFERENCE BETWEEN HD6303 AND HD6303R**

The HD6303R is an upgraded version of the HD6303. The difference between HD6303 and HD6303R is shown in Table 16.

Table 16 Difference between HD6303 and HD6303R

Item	HD6303	HD6303R
Operating Mode	Mode 2: Not defined	Mode 2: Multiplexed Mode (Equivalent to Mode 4)
Electrical Characteristics	The electrical characteristics of 2MHz version (B version) are not specified.	Some characteristics are improved. The 2MHz version is guaranteed.
Timer	Has problem in output compare function. (Can be avoided by software.)	The problem is solved.

HD6303X, HD63A03X, HD63B03X

CMOS MPU (Micro Processing Unit)

—PRELIMINARY—

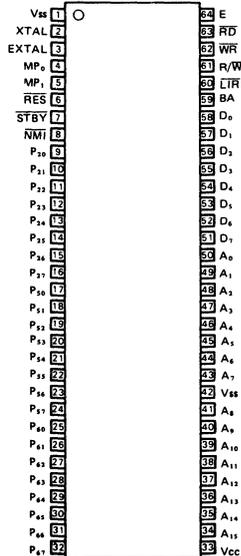
The HD6303X is a CMOS 8-bit microprocessing unit (MPU) which includes a CPU compatible with the HD6301V1, 192 bytes of RAM, 24 parallel I/O pins, a Serial Communication Interface (SCI) and two timers on chip.

■ FEATURES

- Instruction Set Compatible with the HD6301V1
- Abundant On-chip Functions
 - 192 Bytes of RAM
 - 24 Parallel I/O Ports
 - 16-Bit Programmable Timer
 - 8-Bit Reloadable Timer
 - Serial Communication Interface
 - Memory Ready
 - Halt
 - Error-Detection (Address Trap, Op Code Trap)
- Interrupts . . . 3 External, 7 Internal
- Up to 65k Words Address Space
- Low Power Dissipation Mode
 - Sleep
 - Standby
- Wide Range of Operation
 - $V_{CC} = 3 \sim 6V$ ($f = 0.1 \sim 0.5MHz$).
 - $V_{CC} = 5V \pm 10\%$
 - $f = 0.5 \sim 1.0MHz$; HD6303X
 - $f = 0.5 \sim 1.5MHz$; HD63A03X
 - $f = 0.5 \sim 2.0MHz$; HD63B03X

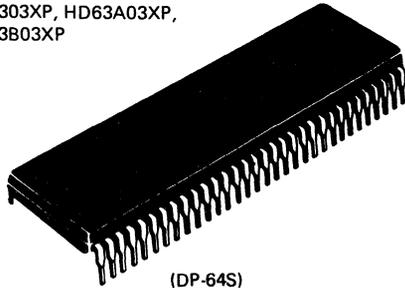
■ PIN ARRANGEMENT

- HD6303XP, HD63A03XP, HD63B03XP



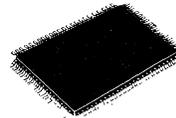
(Top View)

HD6303XP, HD63A03XP,
HD63B03XP



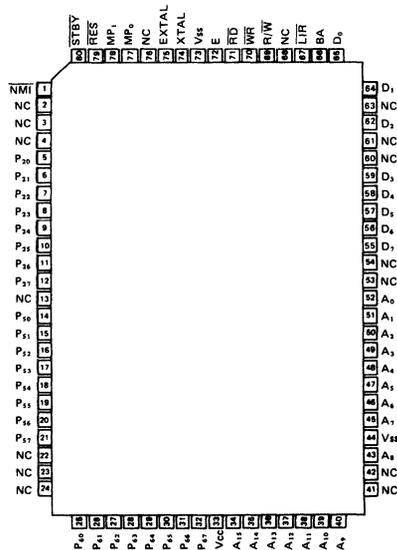
(DP-64S)

HD6303XF, HD63A03XF,
HD63B03XF

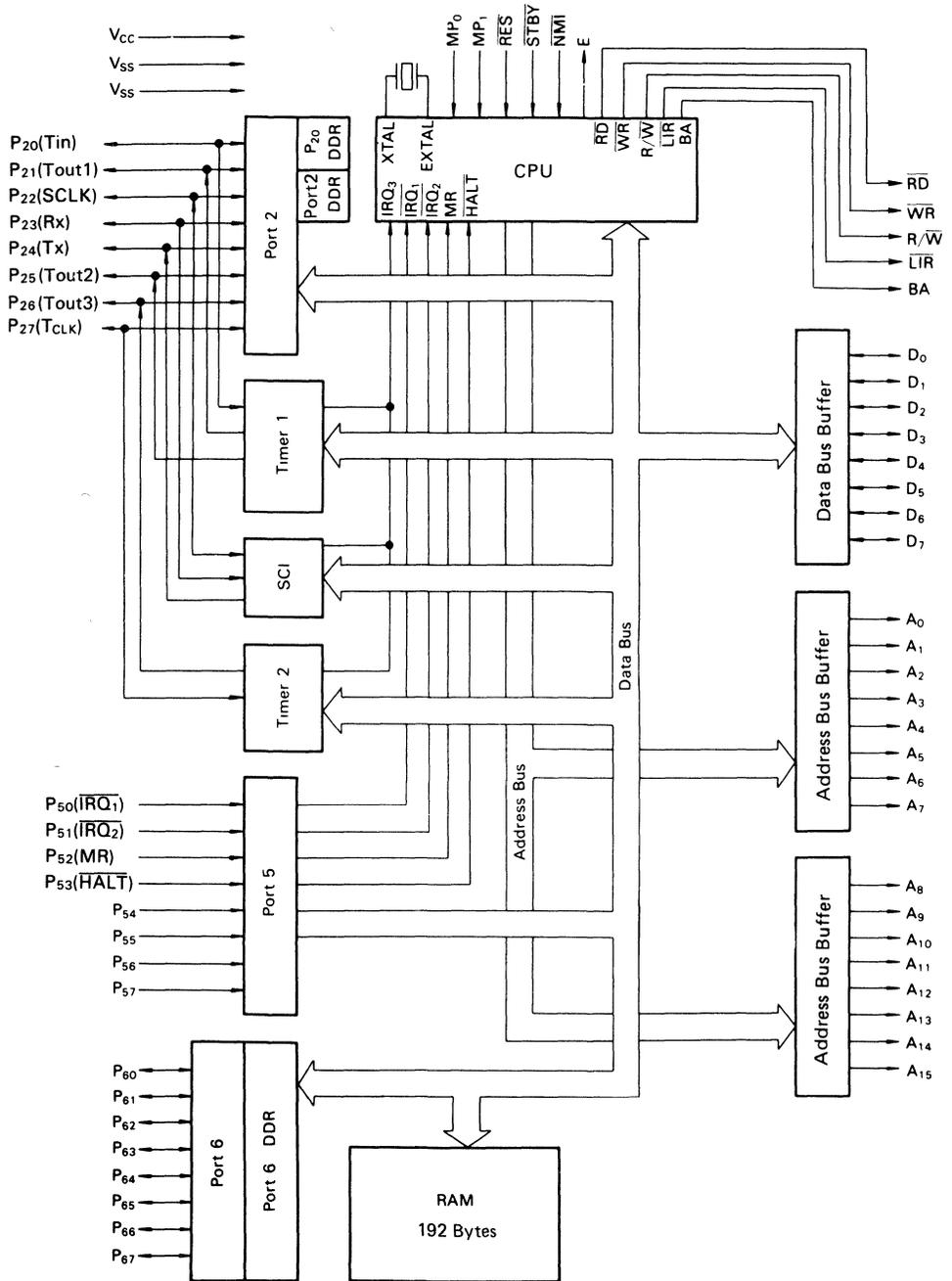


(FP-80)

- HD6303XF, HD63A03XF, HD63B03XF



■ BLOCK DIAGRAM



■ ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Value	Unit
Supply Voltage	V_{CC}	-0.3 ~ +7.0	V
Input Voltage	V_{in}	-0.3 ~ $V_{CC}+0.3$	V
Operating Temperature	T_{opr}	0 ~ +70	°C
Storage Temperature	T_{stg}	-55 ~ +150	°C

(NOTE) This product has protection circuits in input terminal from high static electricity voltage and high electric field. But be careful not to apply overvoltage more than maximum ratings to these high input impedance protection circuits. To assure the normal operation, we recommend V_{in} , V_{out} : $V_{SS} \leq (V_{in} \text{ or } V_{out}) \leq V_{CC}$.

■ ELECTRICAL CHARACTERISTICS

● DC CHARACTERISTICS ($V_{CC} = 5.0V \pm 10\%$, $V_{SS} = 0V$, $T_a = 0 \sim +70^\circ C$, unless otherwise noted.)

Item	Symbol	Test Condition	min	typ	max	Unit	
Input "High" Voltage	V_{IH}		$V_{CC}-0.5$	-	$V_{CC}+0.3$	V	
			$V_{CC} \times 0.7$	-			
			2.0	-			
Input "Low" Voltage	V_{IL}		-0.3	-	0.8	V	
Input Leakage Current	$ I_{in} $	$V_{in} = 0.5 \sim V_{CC}-0.5V$	-	-	1.0	μA	
Three State (off-state) Leakage Current	$ I_{TSI} $	$V_{in} = 0.5 \sim V_{CC}-0.5V$	-	-	1.0	μA	
Output "High" Voltage	V_{OH}		$I_{OH} = -200\mu A$	2.4	-	V	
			$I_{OH} = -10\mu A$	$V_{CC}-0.7$	-	V	
Output "Low" Voltage	V_{OL}	$I_{OL} = 1.6mA$	-	-	0.4	V	
Darlington Drive Current	$-I_{OH}$	$V_{out} = 1.5V$	1.0	-	10.0	mA	
Input Capacitance	C_{in}	$V_{in} = 0V, f = 1MHz, T_a = 25^\circ C$	-	-	12.5	pF	
Standby Current	I_{STB}		-	3.0	15.0	μA	
Current Dissipation *	I_{SLP}		Sleeping (f = 1MHz**)	-	1.5	3.0	mA
			Sleeping (f = 1.5MHz**)	-	2.3	4.5	mA
			Sleeping (f = 2MHz**)	-	3.0	6.0	mA
	I_{CC}		Operating (f = 1MHz**)	-	7.0	10.0	mA
			Operating (f = 1.5MHz**)	-	10.5	15.0	mA
			Operating (f = 2MHz**)	-	14.0	20.0	mA
RAM Standby Voltage	V_{RAM}		2.0	-	-	V	

* V_{IH} min = $V_{CC}-1.0V$, V_{IL} max = 0.8V, All output terminals are at no load.

** Current Dissipation of the operating or sleeping condition is proportional to the operating frequency. So the typ. or max. values about Current Dissipations at x MHz operation are decided according to the following formula;

$$\begin{aligned} \text{typ. value (f = x MHz)} &= \text{typ. value (f = 1MHz)} \times x \\ \text{max. value (f = x MHz)} &= \text{max. value (f = 1MHz)} \times x \\ &\text{(both the sleeping and operating)} \end{aligned}$$

● AC CHARACTERISTICS (V_{CC} = 5.0V±10%, V_{SS} = 0V, T_a = 0 ~ +70°C, unless otherwise noted.)

BUS TIMING

Item	Symbol	Test Condition	HD6303X			HD63A03X			HD63B03X			Unit	
			min	typ	max	min	typ	max	min	typ	max		
Cycle Time	t _{cyc}	Fig. 1	1	—	10	0.666	—	10	0.5	—	10	μs	
Enable Rise Time	t _{Er}		—	—	25	—	—	25	—	—	25	ns	
Enable Fall Time	t _{Ef}		—	—	25	—	—	25	—	—	25	ns	
Enable Pulse Width "High" Level*	PW _{EH}		450	—	—	300	—	—	220	—	—	ns	
Enable Pulse Width "Low" Level*	PW _{EL}		450	—	—	300	—	—	220	—	—	ns	
Address, R/W Delay Time*	t _{AD}		—	—	250	—	—	190	—	—	160	ns	
Data Delay Time	Write		t _{DDW}	—	—	200	—	—	160	—	—	120	ns
Data Set-up Time	Read		t _{DSR}	80	—	—	70	—	—	70	—	—	ns
Address, R/W Hold Time*	t _{AH}		80	—	—	50	—	—	35	—	—	ns	
Data Hold Time	Write*		t _{HW}	80	—	—	50	—	—	40	—	—	ns
	Read		t _{HR}	0	—	—	0	—	—	0	—	—	ns
RD, WR Pulse Width*	PW _{RW}		450	—	—	300	—	—	220	—	—	ns	
RD, WR Delay Time	t _{RWD}		—	—	40	—	—	40	—	—	40	ns	
RD, WR Hold Time	t _{HRW}		—	—	30	—	—	30	—	—	25	ns	
LIR Delay Time	t _{DLR}		—	—	200	—	—	160	—	—	120	ns	
LIR Hold Time	t _{HLR}	10	—	—	10	—	—	10	—	—	ns		
MR Set-up Time*	t _{SMR}	Fig. 2	400	—	—	280	—	—	230	—	—	ns	
MR Hold Time*	t _{HMR}		—	—	90	—	—	40	—	—	0	ns	
E Clock Pulse Width at MR	PW _{EMR}		—	—	9	—	—	9	—	—	9	μs	
Processor Control Set-up Time	t _{PCS}	Fig. 3, 10, 11	200	—	—	200	—	—	200	—	—	ns	
Processor Control Rise Time	t _{PCr}	Fig. 2, 3	—	—	100	—	—	100	—	—	100	ns	
Processor Control Fall Time	t _{PCf}		—	—	100	—	—	100	—	—	100	ns	
BA Delay Time	t _{BA}	Fig. 3	—	—	250	—	—	190	—	—	160	ns	
Oscillator Stabilization Time	t _{RC}	Fig. 11	20	—	—	20	—	—	20	—	—	ms	
Reset Pulse Width	PW _{RST}		3	—	—	3	—	—	3	—	—	t _{cyc}	

* These timings change in approximate proportion to t_{cyc}. The figures in this characteristics represent those when t_{cyc} is minimum (= in the highest speed operation).

PERIPHERAL PORT TIMING

Item	Symbol	Test Condition	HD6303X			HD63A03X			HD63B03X			Unit	
			min	typ	max	min	typ	max	min	typ	max		
Peripheral Data Set-up Time	Ports 2, 5, 6	t _{PDSU}	Fig. 5	200	—	—	200	—	—	200	—	—	ns
Peripheral Data Hold Time	Ports 2, 5, 6	t _{PDH}	Fig. 5	200	—	—	200	—	—	200	—	—	ns
Delay Time (Enable Negative Transition to Peripheral Data Valid)	Ports 2, 6	t _{PWD}	Fig. 6	—	—	300	—	—	300	—	—	300	ns

TIMER, SCI TIMING

Item	Symbol	Test Condition	HD6303X			HD63A03X			HD63B03X			Unit
			min	typ	max	min	typ	max	min	typ	max	
Timer 1 Input Pulse Width	t _{PWT}	Fig. 8	2.0	—	—	2.0	—	—	2.0	—	—	t _{cyc}
Delay Time (Enable Positive Transition to Timer Output)	t _{TOD}	Fig. 7	—	—	400	—	—	400	—	—	400	ns
SCI Input Clock Cycle	Async. Mode	Fig. 8	1.0	—	—	1.0	—	—	1.0	—	—	t _{cyc}
	Clock Sync.	Fig. 4, 8	2.0	—	—	2.0	—	—	2.0	—	—	t _{cyc}
SCI Transmit Data Delay Time (Clock Sync. Mode)	t _{TXD}	Fig. 4	—	—	200	—	—	200	—	—	200	ns
SCI Receive Data Set-up Time (Clock Sync. Mode)	t _{SRX}		290	—	—	290	—	—	290	—	—	ns
SCI Receive Data Hold Time (Clock Sync. Mode)	t _{H RX}		100	—	—	100	—	—	100	—	—	ns
SCI Input Clock Pulse Width	t _{PWSCK}	Fig. 8	0.4	—	0.6	0.4	—	0.6	0.4	—	0.6	t _{Scyc}
Timer 2 Input Clock Cycle	t _{tcyc}		2.0	—	—	2.0	—	—	2.0	—	—	t _{cyc}
Timer 2 Input Clock Pulse Width	t _{PWTCK}		200	—	—	200	—	—	200	—	—	ns
Timer 1-2, SCI Input Clock Rise Time	t _{CKr}		—	—	100	—	—	100	—	—	100	ns
Timer 1-2, SCI Input Clock Fall Time	t _{CKf}		—	—	100	—	—	100	—	—	100	ns

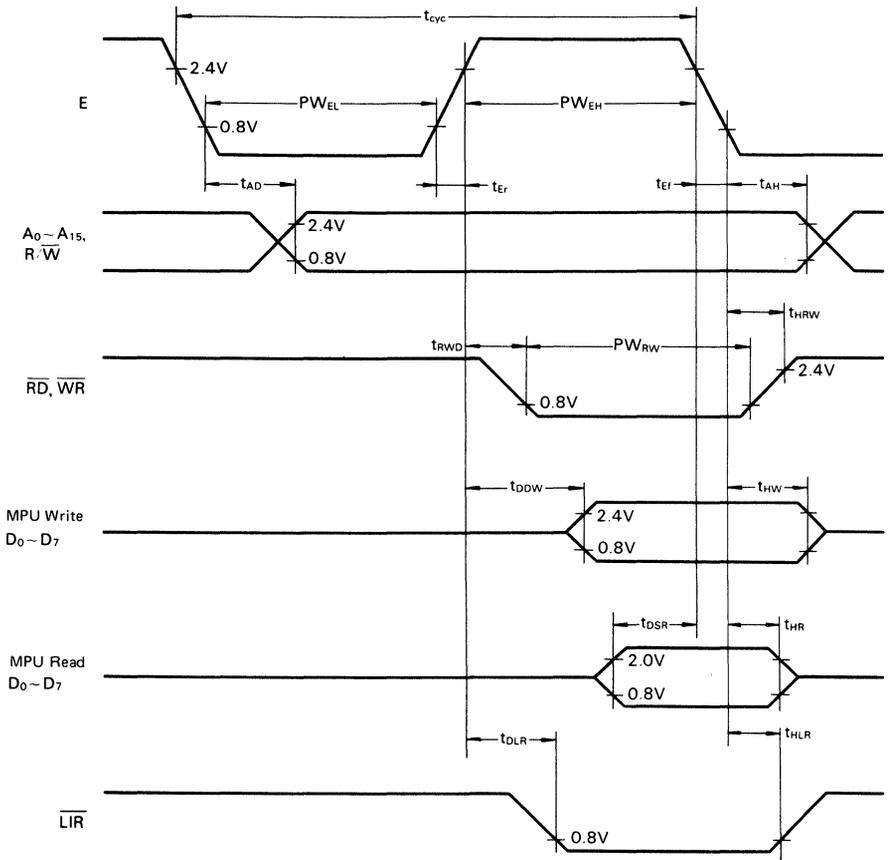


Figure 1 Bus Timing

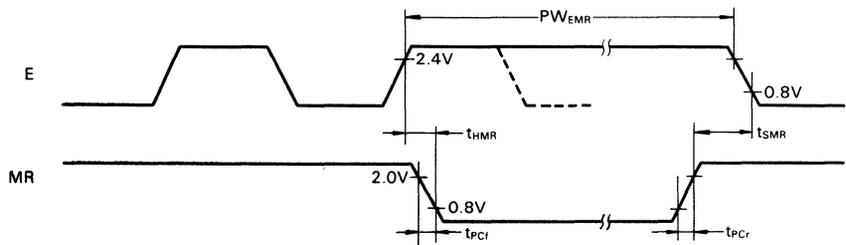


Figure 2 Memory Ready and E Clock Timing

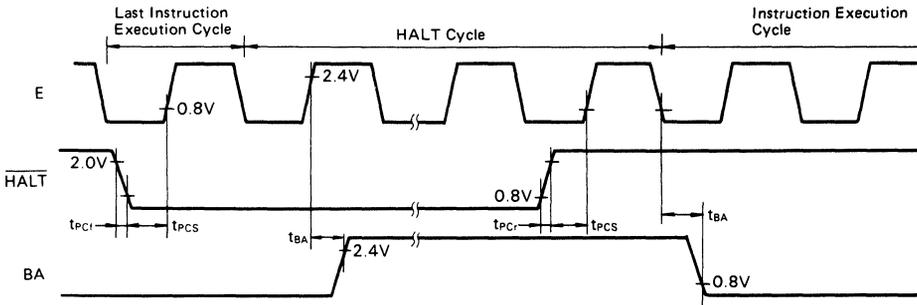
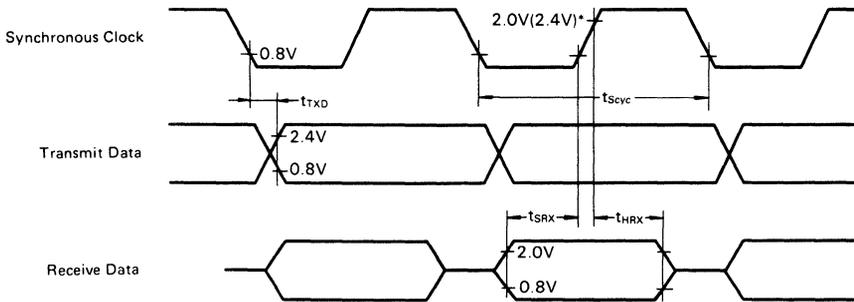


Figure 3 $\overline{\text{HALT}}$ and BA Timing



* 2.0V is high level when clock input.
2.4V is high level when clock output.

Figure 4 SCI Clocked Synchronous Timing

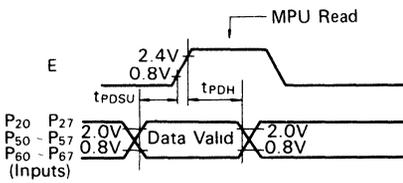


Figure 5 Port Data Set-up and Hold Times (MPU Read)

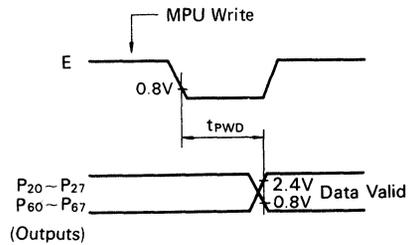
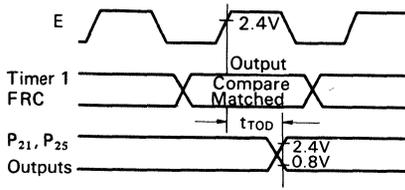
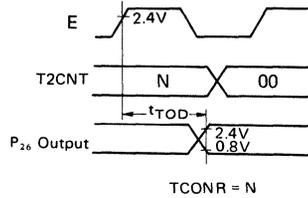


Figure 6 Port Data Delay Times (MPU Write)



(a) Timer 1 Output Timing



(b) Timer 2 Output Timing

Figure 7 Timer Output Timing

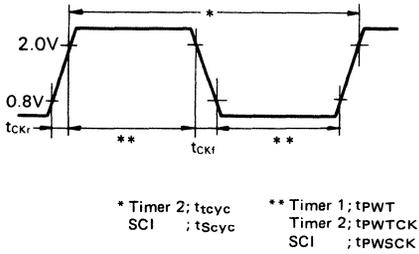
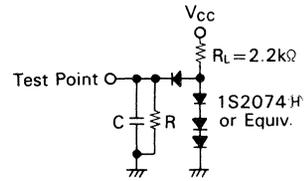


Figure 8 Timer 1-2, SCI Input Clock Timing



C=90pF for D₀~D₇, A₀~A₁₅, E
 =30pF for Port 2, Port 6, RD, WR, R/W, BA, LIR
 R=12kΩ for D₀~D₇, A₀~A₁₅, E, Port 2, Port 6,
 RD, WR, R/W, BA, LIR

Figure 9 Bus Timing Test Loads (TTL Load)

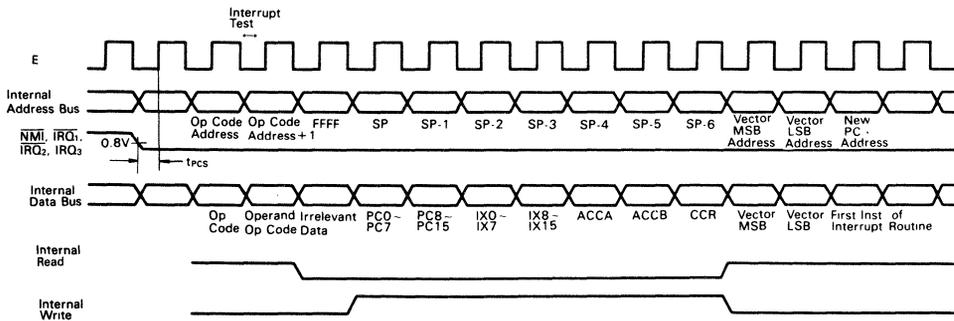


Figure 10 Interrupt Sequence

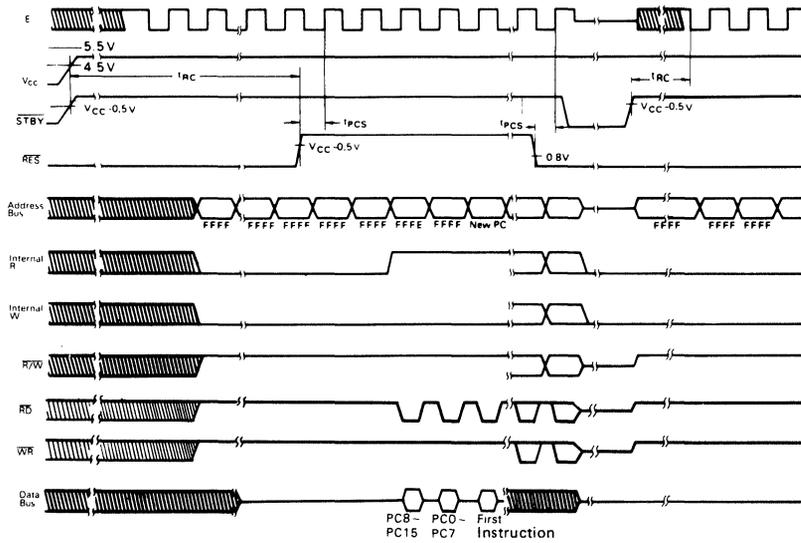


Figure 11 Reset Timing

FUNCTIONAL PIN DESCRIPTION

V_{CC}, V_{SS}

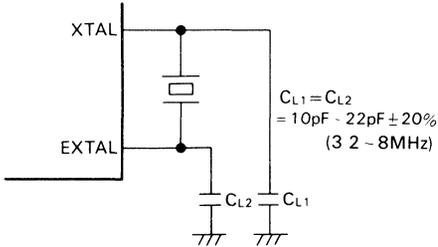
V_{CC} and V_{SS} provide power to the MPU with 5V±10% supply. In the case of low speed operation (f_{max} = 500kHz), the MPU can operate with three through six volts. Two V_{SS} pins should be tied to ground.

XTAL, EXTAL

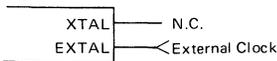
These two pins interface with an AT-cut parallel resonant crystal. Divide-by-four circuit is on chip, so if 4MHz crystal oscillator is used, the system clock is 1MHz for example.

AT Cut Parallel Resonant Crystal Oscillator

C₀ = 7pF max
R_S = 60Ω max



(a) Crystal Interface



(b) External Clock

Figure 12 Connection Circuit

EXTAL pin is drivable with the external clock of 45 to 50% duty, and one fourth frequency of the external clock is produced in the LSI. The external clock frequency should be less than four times of the maximum operable frequency. When using the external clock, XTAL pin should be open. Fig. 12 shows examples of connection circuit. The crystal and C_{L1}, C_{L2} should be mounted as close as possible to XTAL and EXTAL pins. Any line must not cross the line between the crystal oscillator and XTAL, EXTAL.

STBY

This pin makes the MPU standby mode. In "Low" level, the oscillation stops and the internal clock is stabilized to make reset condition. To retain the contents of RAM at standby, "0" should be written into RAM enable bit (RAME). RAME is the bit 6 of the RAM/port 5 control register at \$0014. RAM is disabled by this operation and its contents is sustained.

Refer to "LOW POWER DISSIPATION MODE" for the standby mode.

Reset (RES)

This pin is used to reset the MPU from power OFF state and to provide a startup procedure. During power-on, RES pin must be held "Low" level for at least 20ms.

The CPU registers (accumulator, index register, stack pointer, condition code register except for interrupt mask bit), RAM and the data register of a port are not initialized during reset, so their contents are unknown in this procedure.

To reset the MPU during operation, RES should be held "Low" for at least 3 system-clock cycles. At the 3rd cycle during "Low" level, all the address buses become "High". When RES remains "Low", the address buses keep "High". If RES becomes "High", the MPU starts the next operation.

(1) Latch the value of the mode program pins; MP₀ and MP₁.

- (2) Initialize each internal register (Refer to Table 3).
- (3) Set the interrupt mask bit. For the CPU to recognize the maskable interrupts \overline{IRQ}_1 , \overline{IRQ}_2 and \overline{IRQ}_3 , this bit should be cleared in advance.
- (4) Put the contents (= start address) of the last two addresses (\$FFFE, \$FFFF) into the program counter and start the program from this address. (Refer to Table 1).

*The MPU is usable to accept a reset input until the clock becomes normal oscillation after power on (max. 20ms). During this transient time, the MPU and I/O pins are undefined. Please be aware of this for system designing.

● **Enable (E)**

This pin provides a TTL-compatible system clock to external circuits. Its frequency is one fourth that of the crystal oscillator or external clock. This pin can drive one TTL load and 90pF capacitance.

● **Non-Maskable Interrupt (\overline{NMI})**

When the falling edge of the input signal is detected at this pin, the CPU begins non-maskable interrupt sequence internally. As well as the IRQ mentioned below, the instruction being executed at \overline{NMI} signal detection will proceed to its completion. The interrupt mask bit of the condition code register doesn't affect non-maskable interrupt at all.

When starting the acknowledge to the \overline{NMI} , the contents of the program counter, index register, accumulators and condition code register will be saved onto the stack. Upon completion

of this sequence, a vector is fetched from \$FFFC and \$FFFD to transfer their contents into the program counter and branch to the non-maskable interrupt service routine. After reset start, the stack pointer should be initialized on an appropriate memory area and then the falling edge be input to \overline{NMI} pin.

● **Interrupt Request (\overline{IRQ}_1 , \overline{IRQ}_2)**

These are level-sensitive pins which request an internal interrupt sequence to the CPU. At interrupt request, the CPU will complete the current instruction before its request acknowledgement. Unless the interrupt mask in the condition code register is set, the CPU starts an interrupt sequence; if set, the interrupt request will be ignored. When the sequence starts, the contents of the program counter, index register, accumulators and condition code register will be saved onto the stack, then the CPU sets the interrupt mask bit and will not acknowledge the maskable request. During the last cycle, the CPU fetches vectors depicted in Table 1 and transfers their contents to the program counter and branches to the service routine.

The CPU uses the external interrupt pins, \overline{IRQ}_1 and \overline{IRQ}_2 also as port pins P_{50} and P_{51} , so it provides an enable bit to Bit 0 and 1 of the RAM port 5 control register at \$0014. Refer to "RAM/PORT 5 CONTROL REGISTER" for the details.

When one of the internal interrupts, ICI, OCI, TOI, CMI or SIO is generated, the CPU produces internal interrupt signal (\overline{IRQ}_3). \overline{IRQ}_3 functions just the same as \overline{IRQ}_1 or \overline{IRQ}_2 except for its vector address. Fig. 13 shows the block diagram of the interrupt circuit.

Table 1 Interrupt Vector Memory Map

Priority	Vector		Interrupt
	MSB	LSB	
Highest ↑ ↓ Lowest	FFFE	FFFF	\overline{RES}
	FFEE	FFEF	TRAP
	FFFC	FFFD	\overline{NMI}
	FFFA	FFFB	SWI (Software Interrupt)
	FFF8	FFF9	\overline{IRQ}_1
	FFF6	FFF7	ICI (Timer 1 Input Capture)
	FFF4	FFF5	OCI (Timer 1 Output Compare 1, 2)
	FFF2	FFF3	TOI (Timer 1 Overflow)
	FFEC	FFED	CMI (Timer 2 Counter Match)
	FFEA	FFEB	\overline{IRQ}_2
	FFF0	FFF1	SIO (RDRF+ORFE+TDRE)

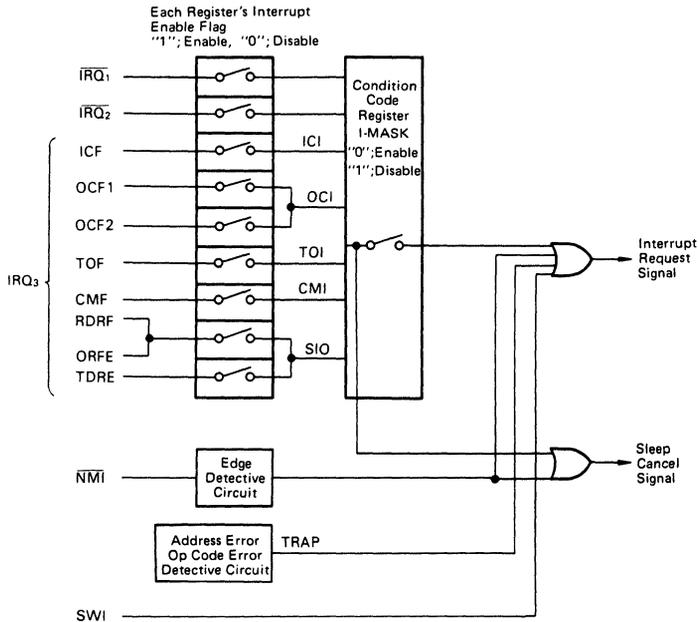


Figure 13 Interrupt Circuit Block Diagram

• **Mode Program (MP₀, MP₁)**

To operate MPU, MP₀ pin should be connected to "High" level and MP₁ should be connected to "Low" level (refer to Fig. 15).

• **Read/Write (R/W)**

This signal, usually be in read state ("High"), shows whether the MPU is in read ("High") or write ("Low") state to the peripheral or memory devices. This can drive one TTL load and 30pF capacitance.

• **\overline{RD} , \overline{WR}**

These signals show active low outputs when the CPU is reading/writing to the peripherals or memories. This enables the CPU easy to access the peripheral LSI with \overline{RD} and \overline{WR} input pins. These pins can drive one TTL load and 30pF capacitance.

• **Load Instruction Register (\overline{LIR})**

This signal shows the instruction opcode being on data bus (active low). This pin can drive one TTL load and 30pF capacitance.

• **Memory Ready (MR; P₅₂)**

This is the input control signal which stretches the system clock's "High" period to access low-speed memories. During this signal being in "High", the system clock operates in normal sequence. But this signal in "Low", the "High" period of the system clock will be stretched depending on its "Low" level duration in integral multiples of the cycle time. This allows the CPU to interface with low-speed memories (see Fig. 2). Up to

9 μ s can be stretched.

During internal address space access or nonvalid memory access, MR is prohibited internally to prevent decrease of operation speed. Even in the halt state, MR can also stretch "High" period of system clock to allow peripheral devices to access low-speed memories. As this signal is used also as P₅₂, an enable bit is provided at bit 2 of the RAM/port 5 control register at \$0014. Refer to "RAM/PORT 5 CONTROL REGISTER" for more details.

• **Halt (\overline{HALT} ; P₅₃)**

This is an input control signal to stop instruction execution and to release buses free. When this signal switches to "Low", the CPU stops to enter into the halt state after having executed the present instruction. When entering into the halt state, it makes BA (P₇₄) "High" and also an address bus, data bus, \overline{RD} , \overline{WR} , R/W in high impedance. When an interrupt is generated in the halt state, the CPU uses the interrupt handler after the halt is cancelled. When halted during the sleep state, the CPU keeps the sleep state, while BA is "High" and releases the buses. Then the CPU returns to the previous sleep state when the \overline{HALT} signal becomes "High". The same thing can be said when the CPU is in the interrupt wait state after having executed the WAI instruction.

• **Bus Available (BA)**

This is an output control signal which is normally "Low" but "High" when the CPU accepts \overline{HALT} and releases the buses. The HD6800 and HD6802 make BA "High" and release the buses at WAI execution, while the HD6303X doesn't make

BA “High” under the same condition. But if the $\overline{\text{HALT}}$ becomes “Low” when the CPU is in the interrupt wait state after having executed the WAI, the CPU makes BA “High” and releases the buses. And when the $\overline{\text{HALT}}$ becomes “High”, the CPU returns to the interrupt wait state.

■ **PORT**

The HD6303X provides three I/O ports. Table 2 gives the address of ports and the data direction register and Fig. 14 the block diagrams of each port.

Table 2 Port and Data Direction Register Address

Port	Port Address	Data Direction Register
Port 2	\$0003	\$0001
Port 5	\$0015	—
Port 6	\$0017	\$0016

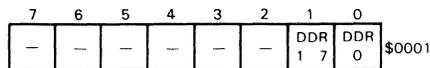
● **Port 2**

An 8-bit input/output port. The data direction register

(DDR) of port 2 is responsible for I/O state. It provides two bits; bit 0 decides the I/O direction of P₂₀ and bit 1 the I/O direction of P₂₁ to P₂₇ (“0” for input, “1” for output).

Port 2 is also used as an I/O pin for the timers and the SCI, port 2 except P₂₀ automatically becomes an input or an output depending on their functions regardless of the data direction register’s value.

Port 2 Data Direction Register



A reset clears the DDR of port 2 and configures port 2 as an input port. This port can drive one TTL and 30pF. In addition, it can produce 1mA current when V_{out} = 1.5V to drive directly the base of Darlington transistors.

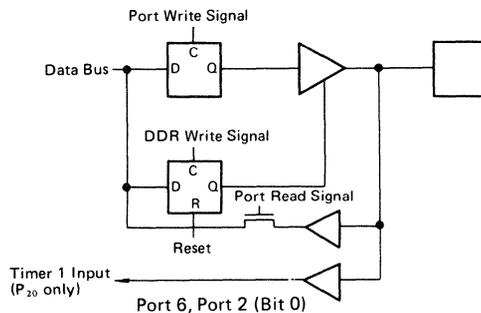
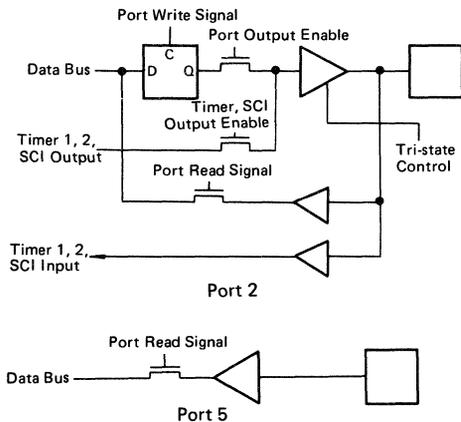


Figure 14 Port Block Diagram

● **Port 5**

An 8-bit port for input only. The lower four bits are also usable as input pins for interrupt, MR and $\overline{\text{HALT}}$.

● **Port 6**

An 8-bit I/O port. This port provides an 8-bit DDR corresponding to each bit and can specify input or output by the bit (“0” for input, “1” for output). This port can drive one TTL load and 30pF. A reset clears the DDR of port 6. In addition, it can produce 1mA current when V_{out} = 1.5V to drive directly the base of Darlington transistors.

■ **BUS**

● **D₀~D₇**

These pins are data bus and can drive one TTL load and 90pF capacitance respectively.

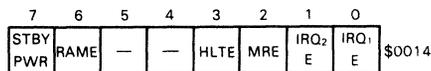
● **A₀~A₁₅**

These pins are address bus and can drive one TTL load and 90pF capacitance respectively.

■ **RAM/PORT 5 CONTROL REGISTER**

The control register located at \$0014 controls on-chip RAM and port 5.

RAM/Port 5 Control Register



Bit 0, Bit 1 $\overline{\text{IRQ}}_1$, $\overline{\text{IRQ}}_2$ Enable Bit (IRQ₁E, IRQ₂E)

When using P₅₀ and P₅₁ as interrupt pins, write “1” in these bits. When “0”, the CPU doesn’t accept an external

interrupt or a sleep cancellation by the external interrupt. These bits become "0" during reset.

Bit 2 Memory Ready Enable Bit (MRE)

When using P_{52} as an input for Memory Ready signal, write "1" in this bit. When "0", the memory ready function is prohibited. This bit becomes "1" during reset.

Bit 3 Halt Enable bit (HLTE)

When using P_{53} as an input for Halt signal, write "1" in this bit. When "0", the halt function is prohibited. This bit becomes "1" during reset.

Bit 4, Bit 5 Not Used.

Bit 6 RAM Enable (RAME)

On-chip RAM can be disabled by this control bit. The MPU Reset sets "1" at this bit and enables on-chip RAM available. This bit can be written "1" or "0" by software. When RAM is in disable condition (=logic "0"), on-chip RAM is invalid and the CPU can read data from external memory. This bit should be "0" at the beginning of standby mode to protect on-chip RAM data.

Bit 7 Standby Power Bit (STBY PWR)

When V_{CC} is not provided in standby mode, this bit is cleared. This is a flag for both read/write by software. If this bit is set before standby mode, and remains set even after returning from standby mode, V_{CC} voltage is provided during standby mode and the on-chip RAM data is valid.

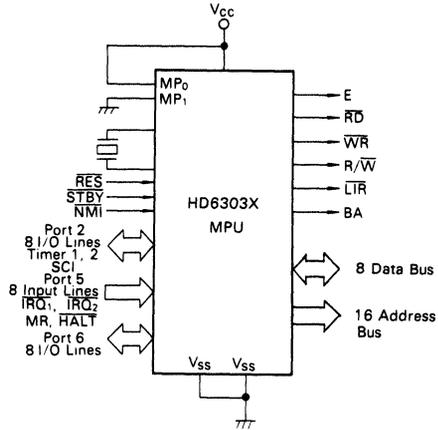


Figure 15 Operation Mode

■ **MEMORY MAP**

The MPU can address up to 65k bytes. Fig. 16 gives memory map of HD6303X. 32 internal registers use addresses from "00" as shown in Table 3.

Table 3 Internal Register

Address	Registers	R/W***	Initialize at RESET
00	-	-	-
01	Port 2 Data Direction Register	W	\$FC
02*	-	-	-
03	Port 2	R/W	Undefined
04*	-	-	-
05	-	-	-
06*	-	-	-
07*	-	-	-
08	Timer Control/Status Register 1	R/W	\$00
09	Free Running Counter ("High")	R/W	\$00
0A	Free Running Counter ("Low")	R/W	\$00
0B	Output Compare Register 1 ("High")	R/W	\$FF
0C	Output Compare Register 1 ("Low")	R/W	\$FF
0D	Input Capture Register ("High")	R	\$00
0E	Input Capture Register ("Low")	R	\$00
0F	Timer Control/Status Register 2	R/W	\$10
10	Rate, Mode Control Register	R/W	\$00
11	Tx/Rx Control Status Register	R/W	\$20
12	Receive Data Register	R	\$00
13	Transmit Data Register	W	\$00
14	RAM/Port 5 Control Register	R/W	\$7C or \$FC
15	Port 5	R	-
16	Port 6 Data Direction Register	W	\$00

(continued)

Table 3 Internal Register

Address	Registers	R/W***	Initialize at RESET
17	Port 6	R/W	Undefined
18*	—	—	—
19	Output Compare Register 2 ("High")	R/W	\$FF
1A	Output Compare Register 2 ("Low")	R/W	\$FF
1B	Timer Control/Status Register 3	R/W	\$20
1C	Time Constant Register	W	\$FF
1D	Timer 2 Up Counter	R/W	\$00
1E	—	—	—
1F**	Test Register	—	—

* External Address.
 ** Test Register. Do not access to this register.
 *** R : Read Only Register
 W : Write Only Register
 R/W : Read/Write Register

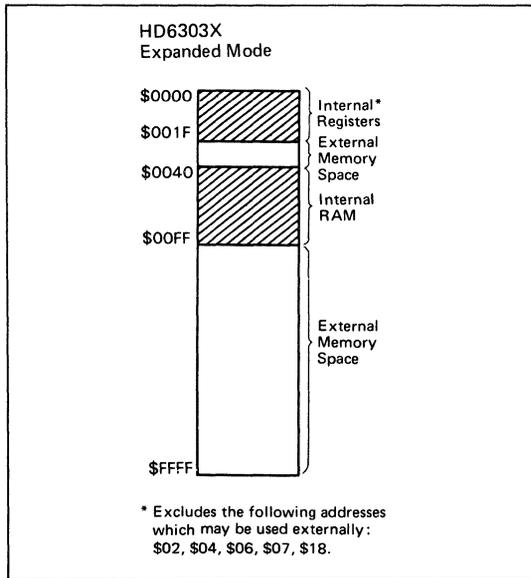


Figure 16 HD6303X Memory Map

■ **TIMER 1**

The HD6303X provides a 16-bit programmable timer which can measure an input waveform and generate two independent output waveforms. The pulse widths of both input/output waveforms vary from microseconds to seconds.

Timer 1 is configured as follows (refer to Fig. 18).

- Control/Status Register 1 (8 bit)
- Control/Status Register 2 (7 bit)
- Free Running Counter (16 bit)
- Output Compare Register 1 (16 bit)
- Output Compare Register 2 (16 bit)
- Input Capture Register (16 bit)

● **Free-Running Counter (FRC) (\$0009 : 000A)**

The key timer element is a 16-bit free-running counter driven

and incremented by system clock. The counter value is readable by software without affecting the counter. The counter is cleared by reset.

When writing to the MSB byte (\$09), the CPU writes the preset value (\$FFF8) into the counter (address \$09, \$0A) regardless of the write data value. But when writing to the LSB byte (\$0A) after MSB byte writing, the CPU write not only LSB byte data into lower 8 bit, but also MSB byte data into higher 8 bit of the FRC.

The counter will be as follows when the CPU writes to it by double store instructions (STD, STX etc.).

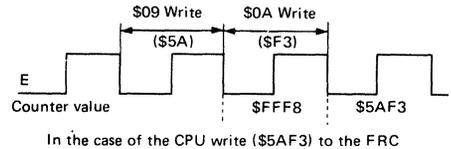


Figure 17 Counter Write Timing

● **Output Compare Register (OCR) (\$000B, \$000C; OCR1) (\$0019, \$001A ; OCR2)**

The output compare register is a 16-bit read/write register which can control an output waveform. It is always compared with the FRC.

When data matches, output compare flag (OCF) in the timer control/status register (TCSR) is set. If an output enable bit (OE) in the TCSR is "1", an output level bit (OLVL) in the TCSR will be output to bit 1 (Tout 1) and bit 5 (Tout 2) of port 2. To control the output level again by the next compare, a change is necessary for the OCR and OLVL. The OCR is set to \$FFFF at reset. The compare function is inhibited for a cycle just after a write to the OCR or to the upper byte of the FRC. This is to set the 16-bit value valid in the register for compare. In addition, it is because \$FFF8 is set at the next cycle of the CPU's MSB byte write to the FRC.

* For data write to the FRC or the OCR, 2-byte transfer instruction (such as STX etc.) should be used.

● **Input Capture Register (ICR) (\$000D : 000E)**

The input capture register is a 16-bit read only register which stores the FRC's value when external input signal transition

generates an input capture pulse. Such transition is defined by input edge bit (IEDG) in the TCSR1.

In order to input the external input signal to the edge detector, a bit of the DDR corresponding to bit 0 of port 2 should be cleared ("0"). When an input capture pulse occurs by input transition at the next cycle of CPU's high-byte read of the ICR, the input capture pulse will be delayed by one cycle. In order to ensure the input capture operation, a CPU read of the ICR needs 2-byte transfer instruction. The input pulse width should be at least 2 system cycles. This register is cleared (\$0000) during reset.

● **Timer Control/Status Register 1 (TCSR1) (\$0008)**

The timer control/status register 1 is an 8-bit register. All bits are readable and the lower 5 bits are also writable. The upper 3 bits are read only which indicate the following timer status.

Bit 5 The counter value reached to \$0000 as a result of counting-up (TOF).

Bit 6 A match has occurred between the FCR and the OCR 1 (OCF1).

Bit 7 Defined transition of the timer input signal causes the counter to transfer its data to the ICR (ICF).

The followings are each bit descriptions.

Timer Control/Status Register 1

7	6	5	4	3	2	1	0
ICF	OCF1	TOF	EICI	EOCI1	ETOI	IEDG	OLV1L1

\$0008

Bit 0 OLV1L1 Output Level 1

OLV1L1 is transferred to port 2, bit 1 when a match occurs between the counter and the OCR1. If OE1, namely, bit 0 of the TCSR2, is set to "1", OLV1L1 will appear at bit 1 of port 2.

Bit 1 IEDG Input Edge

This bit determines which rising edge or falling of input signal of port 2, bit 0 will trigger data transfer from the counter to the ICR. For this function, the DDR corresponding to port 2, bit 0 should be cleared beforehand.

IEDG=0, triggered on a falling edge
("High" to "Low")

IEDG=1, triggered on a rising edge
("Low" to "High")

Bit 2 ETOI Enable Timer Overflow Interrupt

When this bit is set, an internal interrupt (IRQ₃) by TOI interrupt is enabled. When cleared, the interrupt is inhibited.

Bit 3 EOCI1 Enable Output Compare Interrupt 1

When this bit is set, an internal interrupt (IRQ₃) by OCI1 interrupt is enabled. When cleared, the interrupt is inhibited.

Bit 4 EICI Enable Input Capture Interrupt

When this bit is set, an internal interrupt (IRQ₃) by ICI interrupt is enabled. When cleared, the interrupt is inhibited.

Bit 5 TOF Timer Overflow Flag

This read only bit is set when the counter increments from \$FFFF by 1. Cleared when the counter's MSB byte (\$0009) is ready by the CPU following the TCSR1 read.

Bit 6 OCF1 Output Compare Flag 1

This read only bit is set when a match occurs between the OCR1 and the FRC. Cleared by writing to

the OCR1 (\$000B or \$000C) following the TCSR1 or TCSR2 read.

Bit 7 ICF Input Capture Flag

This read only bit is set when an input signal of port 2, bit 0 makes a transition as defined by IEDG and the FRC is transferred to the ICR. Cleared when reading the MSB byte (\$0000D) of the ICR following the TCSR1 or TCSR2 read.

● **Timer Control/Status Register 2 (TCSR2) (\$000F)**

The timer control/status register 2 is a 7-bit register. All bits are readable and the lower 4 bits are also writable. But the upper 3 bits are read-only which indicate the following timer status.

Bit 5 A match has occurred between the FRC and the OCR2 (OCF2).

Bit 6 The same status flag as the OCF1 flag of the TCSR1, bit 6.

Bit 7 The same status flag as the ICF flag of the TCSR1, bit 7. The followings are each bit descriptions.

Timer Control/Status Register 2

7	6	5	4	3	2	1	0
ICF	OCF1	OCF2	—	EOCI2	OLVL2	OE2	OE1

\$000F

Bit 0 OE1 Output Enable 1

This bit enables the OLV1L1 to appear at port 2, bit 1 when a match has occurred between the counter and the output compare register 1. When this bit cleared, bit 1 of port 2 will be I/O port. When set, it will be an output of OLV1L1 automatically.

Bit 1 OE2 Output Enable 2

This bit enables the OLV2L2 to appear at port 2, bit 5 when a match has occurred between the counter and the output compare register 2. When this bit cleared, port 2, bit 5 will be I/O port. When set, it will be an output of OLV2L2 automatically.

Bit 2 OLV2L2 Output Level 2

OLV2L2 is transferred to port 2, bit 5 when a match has occurred between the counter and the OCR2. If OE2, namely bit 5 of the TCSR2, is set to "1", OLV2L2 will appear at port 2, bit 5.

Bit 3 EOCI2 Enable Output Compare Interrupt 2

When this bit is set, an internal interrupt (IRQ₃) by OCI2 interrupt is enabled. When cleared, the interrupt is inhibited.

Bit 4 Not Used

Bit 5 OCF2 Output Compare Flag 2

This read-only bit is set when a match has occurred between the counter and the OCR2. Cleared when writing to the OCR2 (\$0019 or \$001A) following the TCSR2 read.

Bit 6 OCF1 Output Compare Flag 1

Bit 7 ICF Input Capture Flag

OCF1 and ICF addresses are partially decoded. CPU read of the TCSR1/TCSR2 makes it possible to read OCF1 and ICF into bit 6 and bit 7.

Both the TCSR1 and TCSR2 will be cleared during reset.

(Note) If OE1 or OE2 is set to "1" before the first output compare match occurs after reset restart, bit 1 or bit 5 of port 2 will produce "0" respectively.

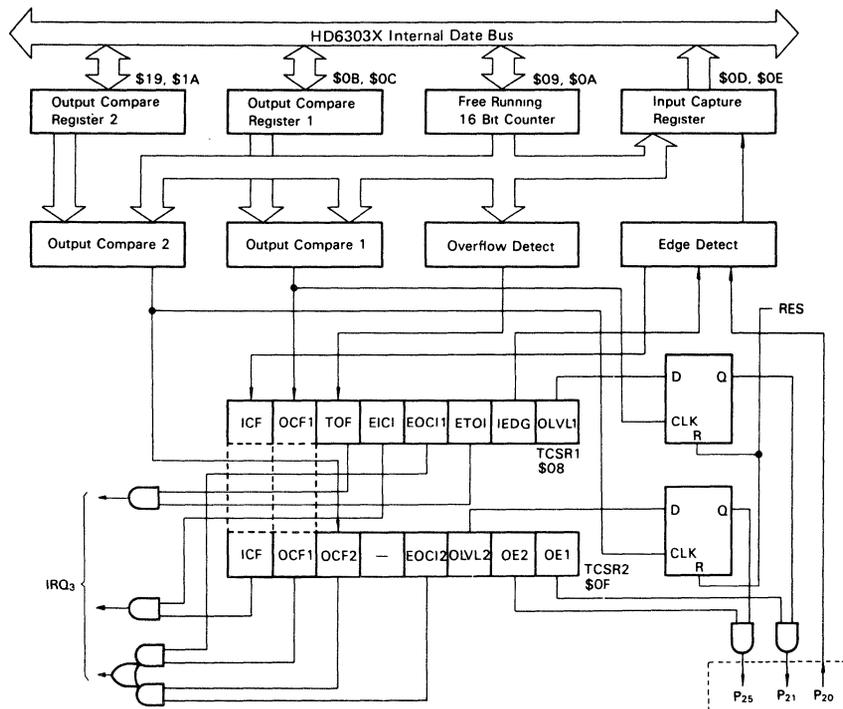


Figure 18 Timer 1 Block Diagram

(Note) Because the set condition of ICF precedes its reset condition, ICF is not cleared when the set condition and the reset condition occur simultaneously. The same phenomenon applies to OCF1, OCF2 or TOF respectively.

■ **TIMER 2**

In addition to the timer 1, the HD6303X provides an 8-bit reloadable timer, which is capable of counting the external event. This timer 2 contains a timer output, so the MPU can generate three independent waveforms (refer to Fig. 19).

The timer 2 is configured as follows:

- Control/Status Register 3 (7 bit)
- 8-bit Up Counter
- Time Constant Register (8 bit)

● **Timer 2 Up Counter (T2CNT) (\$001D)**

This is an 8-bit up counter which operates with the clock decided by CKS0 and CKS1 of the TCSR3. The counter is always readable without affecting itself. In addition, any value can be written to the counter by software even during counting.

The counter is cleared when a match occurs between the counter and the TCONR or during reset.

If a write operation is made by software to the counter at the cycle of counter clear, it does not reset the counter but put the write data to the counter.

● **Time Constant Register (TCONR) (\$001C)**

The time constant register is an 8-bit write only register. It is always compared with the counter.

When a match has occurred, counter match flag (CMF) of the timer control status register 3 (TCSR3) is set and the value selected by TOS0 and TOS1 of the TCSR3 will appear at port 2, bit 6. When CMF is set, the counter will be cleared simultaneously and then start counting from \$00. This enables regular interrupts and waveform outputs without any software support. The TCONR is set to "\$FF" during reset.

● **Timer Control/Status Register 3 (TCSR3) (\$001B)**

The timer control/status register 3 is a 7-bit register. All bits are readable and 6 bits except for CMF can be written.

The followings are each pin descriptions.

Timer Control/Status Register 3							
7	6	5	4	3	2	1	0
CMF	ECMI	—	T2E	TOS1	TOS0	CKS1	CKS0
							\$001B

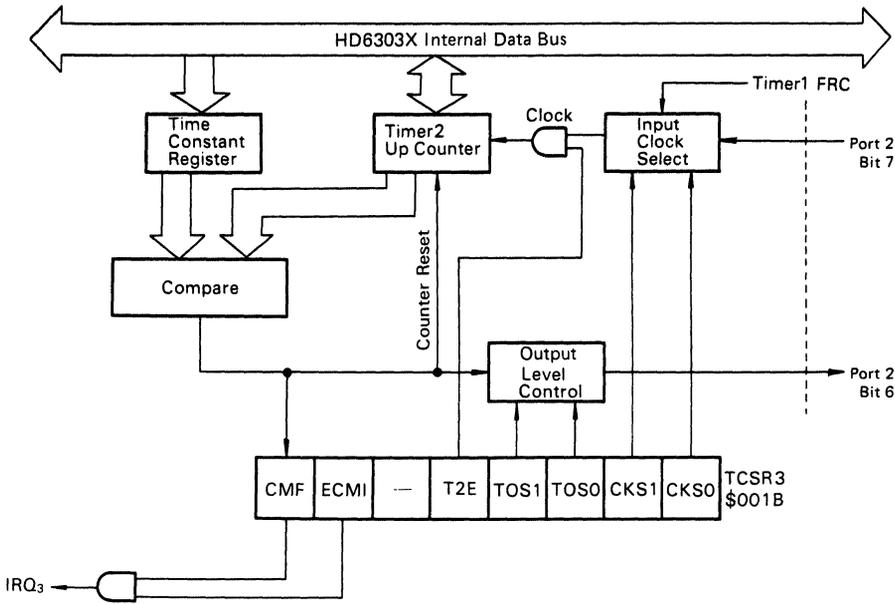


Figure 19 Timer 2 Block Diagram

- Bit 0 CKS0 Input Clock Select 0
- Bit 1 CKS1 Input Clock Select 1

Input clock to the counter is selected as shown in Table 4 depending on these two bits. When an external clock is selected, bit 7 of port 2 will be a clock input automatically. Timer 2 detects the rising edge of the external clock and increments the counter. The external clock is countable up to half the frequency of the system clock.

Table 4 Input Clock Select

CKS1	CKS0	Input Clock to the Counter
0	0	E clock
0	1	E clock/8*
1	0	E clock/128*
1	1	External clock

* These clocks come from the FRC of the timer 1. If one of these clocks is selected as an input clock to the up counter, the CPU should not write to the FRC of the timer 1.

- Bit 2 TOS0 Timer Output Select 0
- Bit 3 TOS1 Timer Output Select 1

When a match occurs between the counter and the TCONR timer 2 outputs shown in Table 5 will appear at port 2, bit 6 depending on these two bits. When both TOS0 and TOS1 are "0", bit 6 of port 2 will be an I/O port.

Table 5 Timer 2 Output Select

TOS1	TOS0	Timer Output
0	0	Timer Output Inhibited
0	1	Toggle Output*
1	0	Output "0"
1	1	Output "1"

* When a match occurs between the counter and the TCONR, timer 2 output level is reversed. This leads to production of a square wave with 50% duty to the external without any software support.

- Bit 4 T2E Timer 2 Enable Bit

When this bit is cleared, a clock input to the up counter is prohibited and the up counter stops. When set to "1", a clock selected by CKS1 and CKS0 (Table 4) is input to the up counter.

(Note) P₂₆ produces "0" when T2E bit cleared and timer 2 set in output enable condition by TOS1 or TOS0. It also produces "0" when T2E bit set "1" and timer 2 set in output enable condition before the first counter match occurs.

- Bit 5 Not Used
- Bit 6 ECMI Enable Counter Match Interrupt
- Bit 7 CMF Counter Match Flag

This read only bit is set when a match occurs between the up counter and the TCONR. Cleared by a software write (unable to write "1" by software).

Each bit of the TCSR3 is cleared during reset.

■ SERIAL COMMUNICATION INTERFACE (SCI)

The HD6303X SCI contains two operation modes; one is an asynchronous mode by the NRZ format and the other is a clocked synchronous mode which transfer data synchronizing with the serial clock.

The serial interface is configured as follows:

- Control/Status Register (TRCSR)
- Rate/Mode Control Register (RMCR)
- Receive Data Register (RDR)
- Receive Data Shift Register (RDSR)
- Transmit Data Register (TDR)
- Transmit Data Shift Register (TDSR)

The serial I/O hardware requires an initialization by software for operation. The procedure is usually as follows:

- 1) Write a desirable operation mode into each corresponding control bit of the RMCR.
- 2) Write a desirable operation mode into each corresponding control bit of the TRCSR.

When using bit 3 and 4 of port 2 for serial I/O only, there is no problem even if TE and RE bit are set. But when setting the baud rate and operation mode, TE and RE should be "0". When clearing TE and RE bit and setting them again, more than 1 bit cycle of the current baud rate is necessary. If set in less than 1 bit cycle, there may be a case that the internal transmit/receive initialization fails.

● Asynchronous Mode

An asynchronous mode contains the following two data formats:

1 Start Bit + 8 Bit Data + 1 Stop Bit
1 Start Bit + 9 Bit Data + 1 Stop Bit

In addition, if the 9th bit is set to "1" when making 9 bit data format, the format of

1 Start bit + 8 Bit Data + 2 Stop Bit

is also transferred.

Data transmission is enabled by setting TE bit of the TRCSR, then port 2, bit 4 will become a serial output independently of the corresponding DDR.

For data transmit, both the RMCR and TRCSR should be set under the desirable operating conditions. When TE bit is set during this process, 10 bit preamble will be sent in 8-bit data format and 11 bit in 9-bit data format. When the preamble is produced, the internal synchronization will become stable and the transmitter is ready to act.

The conditions at this stage are as follows.

- 1) If the TDR is empty (TDRE=1), consecutive 1's are produced to indicate the idle state.
- 2) If the TDR contains data (TDRE=0), data is sent to the transmit data shift register and data transmit starts.

During data transmit, a start bit of "0" is transmitted first. Then 8-bit or 9-bit data (starts from bit 0) and a stop bit of "1"

are transmitted.

When the TDR is "empty", hardware sets TDRE flag bit. If the CPU doesn't respond to the flag in proper timing (the TDRE is in set condition till the next normal data transfer starts from the transmit data), "1" is transferred instead of the start bit "0" and continues to be transferred till data is provided to the data register. While the TDRE is "1", "0" is not transferred.

Data receive is possible by setting RE bit. This makes port 2, bit 3 be a serial input. The operation mode of data receive is decided by the contents of the TRCSR and RMCR. The first "0" (space) synchronizes the receive bit flow. Each bit of the following data will be strobed in the middle. If a stop bit is not "1", a framing error assumed and ORFE is set

When a framing error occurs, receive data is transferred to the receive data register and the CPU can read error-generating data. This makes it possible to detect a line break.

If the stop bit is "1", data is transferred to the receive data register and an interrupt flag RDRF is set. If RDRF is still set when receiving the stop bit of the next data, ORFE is set to indicate overrun generation.

When the CPU read the receive data register as a response to RDRF flag or ORFE flag after having read TRCS, RDRF or ORFE is cleared.

(Note) Clock Source in Asynchronous Mode

When using an internal clock for serial I/O, the followings should be kept in mind.

- Set CC1 and CC0 to "1" and "0" respectively.
- A clock is generated regardless of the value of TE, RE.
- Maximum clock rate is $E \div 16$.
- Output clock rate is the same as bit rate.

When using an external clock for serial I/O, the followings should be kept in mind.

- Set CC1 and CC0 in the RMCR to "1" and "1" respectively.
- The external clock frequency should be set 16 times of the applied baud rate.
- Maximum clock frequency is that of the system clock.

● Clocked Synchronous Mode

In the clocked synchronous mode, data transmit is synchronized with the clock pulse. The HD6303X SCI provides functionally independent transmitter and receiver which makes full duplex operation possible in the asynchronous mode. But in the clocked synchronous mode an SCI clock I/O pin is only P₂₂, so the simultaneous receive and transmit operation is not available. In this mode, TE and RE should not be in set condition ("1") simultaneously. Fig. 21 gives a synchronous clock and a data format in the clocked synchronous mode.

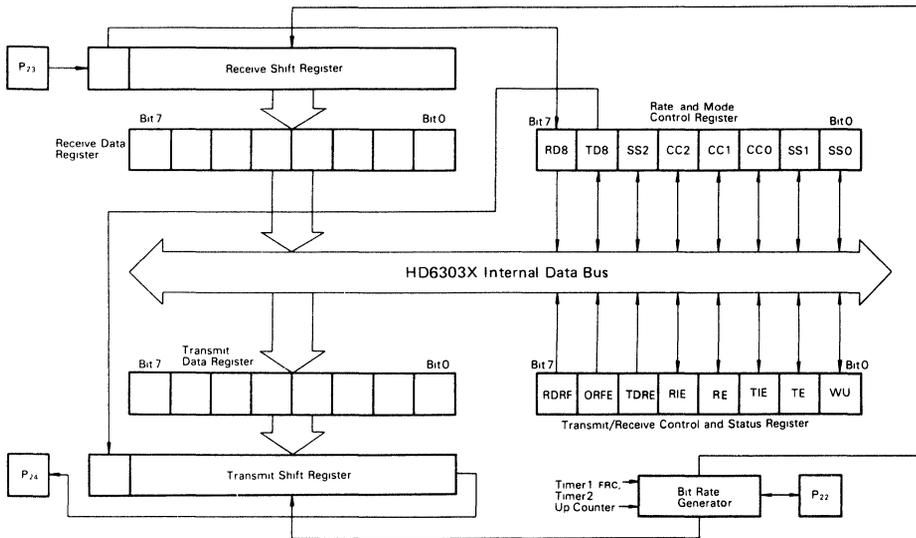


Figure 20 Serial Communication Interface Block Diagram

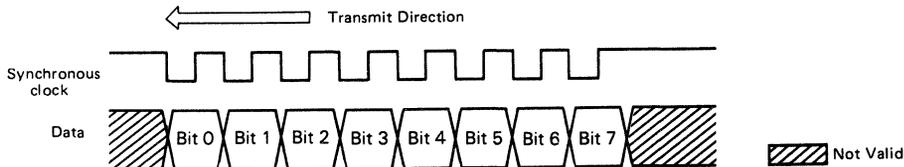
Data transmit is realized by setting TE bit in the TRCSR. Port 2, bit 4 becomes an output unconditionally independent of the value of the corresponding DDR.

Both the RMCR and TRCSR should be set in the desirable operating condition for data transmit.

When an external clock input is selected, data transmit is

performed under the TDRE flag "0" from port 2, bit 4, synchronizing with 8 clock pulses input from external to port 2, bit 2.

Data is transmitted from bit 0 and the TDRE is set when the transmit data shift register is "empty". More than 9th clock pulse of external are ignored.



- Transmit data is produced from a falling edge of a synchronous clock to the next falling edge.
- Receive data is latched at the rising edge.

Figure 21 Clocked Synchronous Mode Format

When data transmit is selected to the clock output, the MPU produces transmit data and synchronous clock at TDRE flag clear.

Data receive is enabled by setting RE bit. Port 2, bit 3 will be a serial input. The operating mode of data receive is decided by the TRCSR and the RMCR.

If the external clock input is selected, RE bit should be set when P22 is "High". Then 8 external clock pulses and the synchronized receive data are input to port 2, bit 2 and bit 3 respectively. The MPU put receive data into the receive data shift register by this clock and set the RDRF flag at the termination of 8 bit data receive. More than 9th clock pulse of external input are ignored. When RDRF is cleared by reading the receive data register, the MPU starts

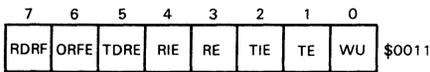
receiving the next data. So RDRF should be cleared with P22 "High".

When data receive is selected to the clock output, 8 synchronous clocks are output to the external by setting RE bit. So receive data should be input from external, synchronously with this clock. When the first byte data is received, the RDRF flag is set. After the second byte, receive operation is performed and output the synchronous clock to the external by clearing the RDRF bit.

• **Transmit/Receive Control Status Register (TRCSR) (\$0011)**

The TRCSR is composed of 8 bits which are all readable. Bits 0 to 4 are also writable. This register is initialized to \$20 during reset. Each bit functions as follows.

Transmit/Receive Control Status Register



- Bit 0 WU Wake-up**
 In a typical multi-processor configuration, the software protocol provides the destination address at the first byte of the message. In order to make uninterested MPU ignore the remaining message, a wake-up function is available. By this, uninterested MPU can inhibit all further receive processing till the next message starts.
 Then wake-up function is triggered by consecutive 1's with 1 frame length (10 bits for 8-bit data, 11 for 9-bit). The software protocol should provide the idle time between messages.
 By setting this bit, the MPU stops data receive till the next message. The receive of consecutive "1" with one frame length wakes up and clears this bit and then the MPU restarts receive operation. However, the RE flag should be already set before setting this bit. In the clocked synchronous mode WU is not available, so this bit should not be set.
- Bit 1 TE Transmit Enable**
 When this bit is set, transmit data will appear at port 2, bit 4 after one frame preamble in asynchronous mode, while in clocked synchronous mode appear immediately. This is executed regardless of the value of the corresponding DDR. When TE is cleared, the serial I/O doesn't affect port 2, bit 4.
- Bit 2 TIE Transmit Interrupt Enable**
 When this bit is set, an internal interrupt (IRQ₃) is enabled when TDRE (bit 5) is set. When cleared, the interrupt is inhibited.
- Bit 3 RE Receive Enable**
 When set, a signal is input to the receiver from port 2, bit 3 regardless of the value of the DDR. When RE is cleared, the serial I/O doesn't affect port 2, bit 3.
- Bit 4 RIE Receive Interrupt Enable**
 When this bit is set, an internal interrupt, IRQ₃ is enabled when RDRF (bit 7) or ORFE (bit 6) is set. When cleared, the interrupt is inhibited.
- Bit 5 TDRE Transmit Data Register Empty**
 TDRE is set when the TDR is transferred to the transmit data shift register in the asynchronous mode, while in clocked synchronous mode when the TDSR is "empty". This bit is reset by reading the TRCSR and writing new transmit data to the transmit data register. TDRE is set to "1" during reset.
- Bit 6 ORFE Overrun Framing Error**
 ORFE is set by hardware when an overrun or a framing error is generated (during data receive only). An overrun error occurs when new receive data is ready to be transferred to the RDR during RDRF still being set. A framing error occurs when a stop bit is "0". But in

clocked synchronous mode, this bit is not affected. This bit is cleared when reading the TRCSR, then the RDR, or during reset.

- Bit 7 RDRF Receive Data Register Full**
 RDRF is set when the RDSR is transferred to the RDR. Cleared when reading the TRCSR, then the RDR, or during reset.
 (Note) When a few bits are set between bit 5 to bit 7 in the TRCSR, a read of the TRCSR is sufficient for clearing those bits. It is not necessary to read the TRCSR every-time to clear each bit.

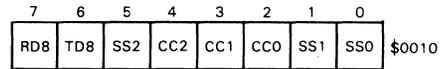
• **Transmit Rate/Mode Control Register (RMCR)**

The RMCR controls the following serial I/O:

- Baud Rate
- Data Format
- Clock Source
- Port 2, Bit 2 Function

In addition, if 9-bit data format is set in the asynchronous mode, the 9th bit is put in this register. All bits are readable and writable except bit 7 (read only). This register is set to S00 during reset.

Transfer Rate/Mode Control Register



- | | | | |
|-------|-----|---|--------------|
| Bit 0 | SS0 | } | Speed Select |
| Bit 1 | SS1 | | |
| Bit 5 | SS2 | | |

These bits control the baud rate used for the SCI. Table 6 lists the available baud rates. The timer 1 FRC (SS2=0) and the timer 2 up counter (SS2=1) provide the internal clock to the SCI. When selecting the timer 2 as a baud rate source, it functions as a baud rate generator. The timer 2 generates the baud rate listed in Table 7 depending on the value of the TCONR.

(Note) When operating the SCI with internal clock, do not perform write operation to the timer/counter which is the clock source of the SCI.

- | | | | |
|-------|-----|---|------------------------------|
| Bit 2 | CC0 | } | Clock Control/Format Select* |
| Bit 3 | CC1 | | |
| Bit 4 | CC2 | | |

These bits control the data format and the clock source (refer to Table 8).

* CC0, CC1 and CC2 are cleared during reset and the MPU goes to the clocked synchronous mode of the external clock operation. Then the MPU forces port 2, bit 2 in the clock input state. When using port 2, bit 2 as an output port, the DDR of port 2 should be set to "1" and CC1 and CC0 to "0" and "1" respectively.

Table 6 SCI Bit Times and Transfer Rates

(1) Asynchronous Mode

SS2	SS1	SS0	XTAL	2.4576MHz	4.0MHz	4.9152MHz
			E	614.4kHz	1.0MHz	1.2288MHz
0	0	0	E ÷ 16	26 μs/38400Baud	16 μs/62500Baud	13 μs/76800Baud
0	0	1	E ÷ 128	208 μs/4800Baud	128 μs/7812.5Baud	104.2 μs/9600Baud
0	1	0	E ÷ 1024	1.67ms/600Baud	1.024ms/976.6Baud	833.3 μs/1200Baud
0	1	1	E ÷ 4096	6.67ms/150Baud	4.096ms/244.1Baud	3.333ms/300Baud
1	—	—	—	*	*	*

* When SS2 is "1", Timer 2 provides SCI clocks. The baud rate is shown as follows with the TCONR as N.

$$\text{Baud Rate} = \frac{f}{32(N+1)} \quad \left(\begin{array}{l} f : \text{input clock frequency to the} \\ \text{timer 2 counter} \\ N = 0 \sim 255 \end{array} \right)$$

(2) Clocked Synchronous Mode *

SS2	SS1	SS0	XTAL	4.0MHz	6.0MHz	8.0MHz
			E	1.0MHz	1.5MHz	2.0MHz
0	0	0	E ÷ 2	2 μs/bit	1.33 μs/bit	1 μs/bit
0	0	1	E ÷ 16	16 μs/bit	10.7 μs/bit	8 μs/bit
0	1	0	E ÷ 128	128 μs/bit	85.3 μs/bit	64 μs/bit
0	1	1	E ÷ 512	512 μs/bit	341 μs/bit	256 μs/bit
1	—	—	—	**	**	**

* Bit rates in the case of internal clock operation. In the case of external clock operation, the external clock is operatable up to DC ~ 1/2 system clock.

** The bit rate is shown as follows with the TCONR as N.

$$\text{Bit Rate } (\mu\text{s/bit}) = \frac{4(N+1)}{f} \quad \left(\begin{array}{l} f : \text{input clock frequency to the} \\ \text{timer 2 counter} \\ N = 0 \sim 255 \end{array} \right)$$

Table 7 Baud Rate and Time Constant Register Example

Baud Rate (Baud)	XTAL	2.4576MHz	3.6864MHz	4.0MHz	4.9152MHz	8.0MHz
110		21*	32*	35*	43*	70*
150		127	191	207	255	51*
300		63	95	103	127	207
600		31	47	51	63	103
1200		15	23	25	31	51
2400		7	11	12	15	25
4800		3	5	—	7	12
9600		1	2	—	3	—
19200		0	—	—	1	—
38400		—	—	—	0	—

* E/8 clock is input to the timer 2 up counter and E clock otherwise.

Table 8 SCI Format and Clock Source Control

CC2	CC1	CC0	Format	Mode	Clock Source	Port 2, Bit 2	Port 2, Bit 3	Port 2, Bit 4
0	0	0	8-bit data	Clocked Synchronous	External	Input	When the TRCSR, RE bit is "1", bit 3 is used as a serial input.	
0	0	1	8-bit data	Asynchronous	Internal	Not Used**		
0	1	0	8-bit data	Asynchronous	Internal	Output*		
0	1	1	8-bit data	Asynchronous	External	Input		
1	0	0	8-bit data	Clocked Synchronous	Internal	Output	When the TRCSR, TE bit is "1", bit 4 is used as a serial output.	
1	0	1	9-bit data	Asynchronous	Internal	Not Used**		
1	1	0	9-bit data	Asynchronous	Internal	Output*		
1	1	1	9-bit data	Asynchronous	External	Input		

* Clock output regardless of the TRCSR, bit RE and TE.

** Not used for the SCI.

Bit 6 TD8 Transmit Data Bit 8

When selecting 9-bit data format in the asynchronous mode, this bit is transmitted as the 9th data. In transmitting 9-bit data, write the 9th data into this bit then write data to the receive data register.

mode, this bit stores the 9th bit data. In receiving 9-bit data, read this bit then the receive data register.

■ **TIMER, SCI STATUS FLAG**

Table 9 shows the set and reset conditions of each status flag in the timer 1, timer 2 and SCI.

Bit 7 RDB Receive Data Bit 8

When selecting 9-bit data format in the asynchronous

Table 9 Timer 1, Timer 2 and SCI Status Flag

		Set Condition	Reset Condition
Timer 1	ICF	FRC → ICR by edge input to P ₂₀ .	1. Read the TCSR1 or TCSR2 then ICRH, when ICF=1 2. RES=0
	OCF1	OCR1=FRC	1. Read the TCSR1 or TCSR2 then write to the OCR1H or OCR1L, when OCF1=1 2. RES=0
	OCF2	OCR2=FRC	1. Read the TCSR2 then write to the OCR2H or OCR2L, when OCF2=1 2. RES=0
	TOF	FRC=\$FFFF+1 cycle	1. Read the TCSR1 then FRCH, when TOF=1 2. RES=0
Timer 2	CMF	T2CNT=TCONR	1. Write "0" to CMF, when CMF=1 2. RES=0
SCI	RDRF	Receive Shift Register → RDR	1. Read the TRCSR then RDR, when RDRF=1 2. RES=0
	ORFE	1. Framing Error (Asynchronous Mode) Stop Bit = 0 2. Overrun Error (Asynchronous Mode) Receive Shift Register → RDR when RDRF=1	1. Read the TRCSR then RDR, when ORFE=1 2. RES=0
	TDRE	1. Asynchronous Mode TDR → Transmit Shift Register 2. Clocked Synchronous Mode Transmit Shift Register is "empty" 3. RES=0	Read the TRCSR then write to the TDR, when TDRE=1

(Note) 1. → ; transfer
2. For example; "ICRH" means High byte of ICR.

■ **LOW POWER DISSIPATION MODE**

The HD6303X provides two low power dissipation modes; sleep and standby.

● **Sleep Mode**

The MPU goes to the sleep mode by SLP instruction execution. In the sleep mode, the CPU stops its operation, while the registers' contents are retained. In this mode, the peripherals except the CPU such as timers, SCI etc. continue their functions. The power dissipation of sleep-condition is one fifth that of operating condition.

The MPU returns from this mode by an interrupt, \overline{RES} or \overline{STBY} ; it goes to the reset state by RES and the standby mode by \overline{STBY} . When the CPU acknowledges an interrupt request, it cancels the sleep mode, returns to the operation mode and branches to the interrupt routine. When the CPU masks this interrupt, it cancels the sleep mode and executes the next instruction. However, for example if the timer 1 or 2 prohibits a timer interrupt, the CPU doesn't cancel the sleep mode because of no interrupt request.

This sleep mode is effective to reduce the power dissipation

for a system with no need of the HD6303X's consecutive operation.

● **Standby Mode**

The HD6303X stops all the clocks and goes to the reset state with \overline{STBY} "Low". In this mode, the power dissipation is reduced conspicuously. All pins except for the power supply, the \overline{STBY} and XTAL are detached from the MPU internally and go to the high impedance state.

In this mode the power is supplied to the HD6303X, so the contents of RAM is retained. The MPU returns from this mode during reset. The followings are typical usage of this mode.

Save the CPU information and SP contents on RAM by \overline{NMI} . Then disable the RAME bit of the RAM control register and set the STBY PWR bit to go to the standby mode. If the STBY PWR bit is still set at reset start, that indicates the power is supplied to the MPU and RAM contents are retained properly. So system can restore itself by returning their pre-standby informations to the SP and the CPU. Fig. 22 depicts the timing at each pin with this example.

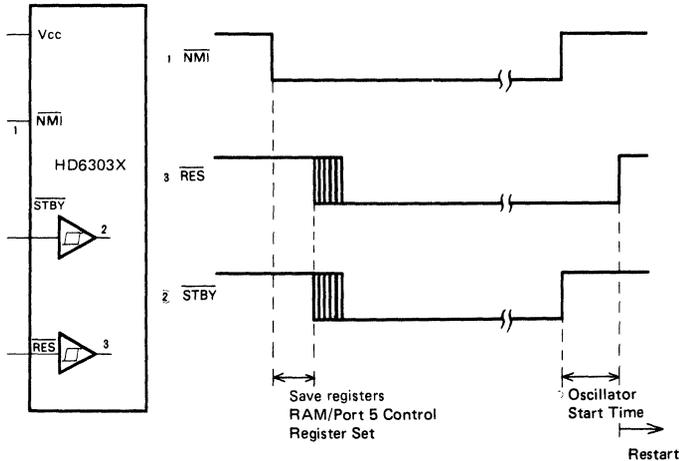


Figure 22 Standby Mode Timing

■ **TRAP FUNCTION**

The CPU generates an interrupt with the highest priority (TRAP) when fetching an undefined instruction or an instruction from non-memory space. The TRAP prevents the system-burst caused by noise or a program error.

● **Op Code Error**

When fetching an undefined op code, the CPU saves CPU registers as well as a normal interrupt and branches to the TRAP (\$FFEE, \$FFEF). This provides the priority next to reset.

● **Address Error**

When an instruction fetch is made from internal register (\$0000~\$001F), the MPU generates an interrupt as well as an op code error. But on the system with no memory in its external memory area, this error processing is not applicable if an instruction fetch is made from the external non-memory

area.

This processing is available only for an instruction fetch and is not applicable to the access of normal data read/write.

(Note) The TRAP interrupt provides a retry function differently from other interrupts. This is a program flow return to the address where the TRAP occurs when a sequence returns to a main routine from the TRAP interrupt routine by RTI. The retry can prevent the system burst caused by noise etc.

However, if another TRAP occurs, the program repeats the TRAP interrupt forever, so the consideration is necessary in programming.

■ **INSTRUCTION SET**

The HD6303X provides object code upward compatible with the HD6801 to utilize all instruction set of the HMCS6800. It also reduces the execution times of key instruc-

tions for throughput improvement.

Bit manipulation instruction, change instruction of the index register and accumulator and sleep instruction are also added.

The followings are explained here.

- CPU Programming Model (refer to Fig. 23)
- Addressing Mode
- Accumulator and Memory Manipulation Instruction (refer to Table 10)
- New Instruction
- Index Register and Stack Manipulation Instruction (refer to Table 11)
- Jump and Branch Instruction (refer to Table 12)
- Condition Code Register Manipulation (refer to Table 13)
- Op Code Map (refer to Table 14)

● **Programming Model**

Fig. 23 depicts the HD6303X programming model. The double accumulator D consists of accumulator A and B, so when using the accumulator D, the contents of A and B are destroyed.

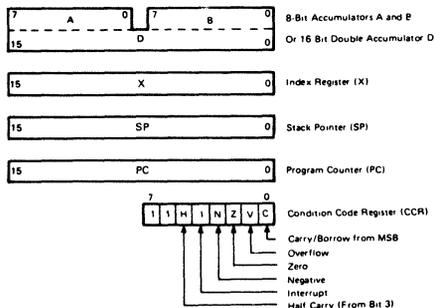


Figure 23 CPU Programming Model

● **CPU Addressing Mode**

The HD6303X provides 7 addressing modes. The addressing mode is decided by an instruction type and code. Table 10 through 14 show addressing modes of each instruction with the execution times counted by the machine cycle.

When the clock frequency is 4 MHz, the machine cycle time becomes microseconds directly.

Accumulator (ACCX) Addressing

Only an accumulator is addressed and the accumulator A or B is selected. This is a one-byte instruction.

Immediate Addressing

This addressing locates a data in the second byte of an instruction. However, LDS and LDX locate a data in the second and third byte exceptionally. This addressing is a 2 or 3-byte instruction.

Direct Addressing

In this addressing mode, the second byte of an instruction shows the address where a data is stored. 256 bytes (\$0 through \$255) can be addressed directly. Execution times can be reduced by storing data in this area so it is recommended to make it RAM for users' data area in configuring a system. This is a 2-byte instruction, while 3 byte with regard to AIM, OIM, EIM and TIM.

Extended Addressing

In this mode, the second byte shows the upper 8 bit of the data stored address and the third byte the lower 8 bit. This indicates the absolute address of 3 byte instruction in the memory.

Indexed Addressing

The second byte of an instruction and the lower 8 bit of the index register are added in this mode. As for AIM, OIM, EIM and TIM, the third byte of an instruction and the lower 8 bits of the index register are added.

This carry is added to the upper 8 bit of the index register and the result is used for addressing the memory. The modified address is retained in the temporary address register, so the contents of the index register doesn't change. This is a 2-byte instruction except AIM, OIM, EIM and TIM (3-byte instruction).

Implied Addressing

An instruction itself specifies the address. That is, the instruction addresses a stack pointer, index register etc. This is a one-byte instruction.

Relative Addressing

The second byte of an instruction and the lower 8 bits of the program counter are added. The carry or borrow is added to the upper 8 bit. So addressing from -126 to +129 byte of the current instruction is enabled. This is a 2-byte instruction.

(Note) CLI, SEI Instructions and Interrupt Operation

When accepting the IRQ at a preset timing with the help of CLI and SEI instructions, more than 2 cycles are necessary between the CLI and SEI instructions. For example, the following program (a) (b) don't accept the IRQ but (c) accepts it.

.	.	.
.	.	.
.	.	.
.	.	CLI
CLI	CLI	NOP
SEI	NOP	NOP
.	SEI	SEI
.	.	.
.	.	.
.	.	.
.	.	.
(a)	(b)	(c)

The same thing can be said to the TAP instruction instead of the CLI and SEI instructions.

Table 10 Accumulator, Memory Manipulation Instructions

Operations	Mnemonic	Addressing Modes												Boolean/ Arithmetic Operation	Condition Code Register												
		IMMED.			DIRECT			INDEX			EXTEND				IMPLIED			5	4	3	2	1	0				
		OP	~	#	OP	~	#	OP	~	#	OP	~	#		OP	~	#	H	I	N	Z	V	C				
Shift Left Arithmetic	ASL									68	6	2	78	6	3	M		•	•	•	•	•	•				
	ASLA														48	1	1	A		•	•	•	•	•	•		
	ASLB														58	1	1	B		•	•	•	•	•	•		
Double Shift Left, Arithmetic	ASLD														05	1	1	C		•	•	•	•	•	•		
Shift Right Arithmetic	ASR							67	6	2	77	6	3	M		•	•	•	•	•	•						
	ASRA														47	1	1	A		•	•	•	•	•	•		
	ASRB														57	1	1	B		•	•	•	•	•	•		
Shift Right Logical	LSR							64	6	2	74	6	3	M		•	•	•	•	R	•						
	LSRA														44	1	1	A		•	•	•	•	R	•		
	LSRB														54	1	1	B		•	•	•	•	R	•		
Double Shift Right Logical	LSRD														04	1	1	C		•	•	•	•	R	•		
Store Accumulator	STAA				97	3	2	A7	4	2	B7	4	3		A → M	•	•	•	•	•	R	•					
	STAB				D7	3	2	E7	4	2	F7	4	3		B → M	•	•	•	•	•	R	•					
Store Double Accumulator	STD				DD	4	2	ED	5	2	FD	5	3		A → M B → M + 1	•	•	•	•	•	R	•					
Subtract	SUBA	80	2	2	90	3	2	A0	4	2	B0	4	3		A - M → A	•	•	•	•	•	•	•					
	SUBB	C0	2	2	D0	3	2	E0	4	2	F0	4	3		B - M → B	•	•	•	•	•	•	•					
Double Subtract	SUBD	83	3	3	93	4	2	A3	5	2	B3	5	3		A : B - M : M + 1 → A : B	•	•	•	•	•	•	•					
Subtract Accumulators	SBA														10	1	1		A - B → A	•	•	•	•	•	•		
Subtract With Carry	SBCA	82	2	2	92	3	2	A2	4	2	B2	4	3		A - M - C → A	•	•	•	•	•	•	•					
	SBCB	C2	2	2	D2	3	2	E2	4	2	F2	4	3		B - M - C → B	•	•	•	•	•	•	•					
Transfer Accumulators	TAB														16	1	1		A → B	•	•	•	•	•	R	•	
	TBA														17	1	1		B → A	•	•	•	•	•	R	•	
Test Zero or Minus	TST							6D	4	2	7D	4	3		M - 00	•	•	•	•	•	•	R	R				
	TSTA														4D	1	1		A - 00	•	•	•	•	•	•	R	R
	TSTB														5D	1	1		B - 00	•	•	•	•	•	•	R	R
And Immediate	AIM				71	6	3	61	7	3		M-IMM -M	•	•	•	•	•	•	•	R	•						
OR Immediate	OIM				72	6	3	62	7	3		M+IMM -M	•	•	•	•	•	•	•	R	•						
EOR Immediate	EIM				75	6	3	65	7	3		M+IMM -M	•	•	•	•	•	•	•	R	•						
Test Immediate	TIM				7B	4	3	6B	5	3		M-IMM	•	•	•	•	•	•	•	R	•						

(Note) Condition Code Register will be explained in Note of Table 13.

• **Additional Instruction**

In addition to the HD6801 instruction set, the HD6303X prepares the following new instructions.

AIM (M)•(IMM) → (M)

Executes "AND" operation to immediate data and the memory contents and stores its result in the memory.

OIM (M) + (IMM) → (M)

Executes "OR" operation to immediate data and the memory contents and stores its result in the memory.

EIM (M) ⊕ (IMM) → (M)

Executes "EOR" operation to immediate data and the memory contents and stores its result in the memory.

TIM (M) • (IMM)

Executes "AND" operation to immediate data and changes the relative flag of the condition code register.

These are 3-byte instructions; the first byte is op code, the second immediate data and the third address modifier.

XGDY (ACCD) ↔ (IX)

Exchanges the contents of accumulator and the index register.

SLP

Goes to the sleep mode. Refer to "LOW POWER DISPENSATION MODE" for more details of the sleep mode.

Table 11 Index Register, Stack Manipulation Instructions

Pointer Operations	Mnemonic	Addressing Modes										Boolean/ Arithmetic Operation	Condition Code Register						
		IMMED.		DIRECT		INDEX		EXTEND		IMPLIED			5	4	3	2	1	0	
		OP	~ #	OP	~ #	OP	~ #	OP	~ #	OP	~ #		H	I	N	Z	V	C	
Compare Index Reg	CPX	8C	3 3	9C	4 2	AC	5 2	BC	5 3				X ← M: M+1	•	•	:	:	:	:
Decrement Index Reg	DEX									09	1 1		X ← X - 1	•	•	•	•	•	•
Decrement Stack Pntr	DES									34	1 1		SP ← SP - 1	•	•	•	•	•	•
Increment Index Reg	INX									08	1 1		X ← X + 1	•	•	•	•	•	•
Increment Stack Pntr	INS									31	1 1		SP ← SP + 1	•	•	•	•	•	•
Load Index Reg	LDX	CE	3 3	DE	4 2	EE	5 2	FE	5 3				M → X _H , (M+1) → X _L	•	•	?	?	R	•
Load Stack Pntr	LDS	8E	3 3	9E	4 2	AE	5 2	BE	5 3				M → SP _H , (M+1) → SP _L	•	•	?	?	R	•
Store Index Reg	STX			DF	4 2	EF	5 2	FF	5 3				X _H → M, X _L → (M+1)	•	•	?	?	R	•
Store Stack Pntr	STS			9F	4 2	AF	5 2	BF	5 3				SP _H → M, SP _L → (M+1)	•	•	?	?	R	•
Index Reg → Stack Pntr	TXS									35	1 1		X ← X - 1	•	•	•	•	•	•
Stack Pntr → Index Reg	TSX									30	1 1		SP ← SP + 1	•	•	•	•	•	•
Add	ABX									3A	1 1		B + X → X	•	•	•	•	•	•
Push Data	PSHX									3C	5 1		X _L → M _{sp} , SP ← SP - 1	•	•	•	•	•	•
													X _H → M _{sp} , SP ← SP - 1	•	•	•	•	•	•
Pull Data	PULX									38	4 1		SP ← SP + 1, M _{sp} → X _H	•	•	•	•	•	•
													SP ← SP + 1, M _{sp} → X _L	•	•	•	•	•	•
Exchange	XGDX									18	2 1		ACCD ← IX	•	•	•	•	•	•

(Note) Condition Code Register will be explained in Note of Table 13.

Table 12 Jump, Branch Instructions

Operations	Mnemonic	Addressing Modes										Branch Test	Condition Code Register						
		RELATIVE		DIRECT		INDEX		EXTEND		IMPLIED			5	4	3	2	1	0	
		OP	~ #	OP	~ #	OP	~ #	OP	~ #	OP	~ #		H	I	N	Z	V	C	
Branch Always	BRA	20	3 2										None	•	•	•	•	•	•
Branch Never	BRN	21	3 2										None	•	•	•	•	•	•
Branch If Carry Clear	BCC	24	3 2										C = 0	•	•	•	•	•	•
Branch If Carry Set	BCS	25	3 2										C = 1	•	•	•	•	•	•
Branch If = Zero	BEQ	27	3 2										Z = 1	•	•	•	•	•	•
Branch If > Zero	BGE	2C	3 2										N ⊕ V = 0	•	•	•	•	•	•
Branch If > Zero	BGT	2E	3 2										Z + (N ⊕ V) = 0	•	•	•	•	•	•
Branch If Higher	BHI	22	3 2										C + Z = 0	•	•	•	•	•	•
Branch If < Zero	BLE	2F	3 2										Z + (N ⊕ V) = 1	•	•	•	•	•	•
Branch If Lower Or Same	BLS	23	3 2										C + Z = 1	•	•	•	•	•	•
Branch If < Zero	BLT	2D	3 2										N ⊕ V = 1	•	•	•	•	•	•
Branch If Minus	BMI	28	3 2										N = 1	•	•	•	•	•	•
Branch If Not Equal Zero	BNE	26	3 2										Z = 0	•	•	•	•	•	•
Branch If Overflow Clear	BVC	28	3 2										V = 0	•	•	•	•	•	•
Branch If Overflow Set	BVS	29	3 2										V = 1	•	•	•	•	•	•
Branch If Plus	BPL	2A	3 2										N = 0	•	•	•	•	•	•
Branch To Subroutine	BSR	8D	5 2											•	•	•	•	•	•
Jump	JMP					6E	3 2	7E	3 3					•	•	•	•	•	•
Jump To Subroutine	JSR			9D	5 2	AD	5 2	BD	6 3					•	•	•	•	•	•
No Operation	NOP									01	1 1		Advances Prog. Cntr. Only	•	•	•	•	•	•
Return From Interrupt	RTI									3B	10 1			•	•	•	•	•	•
Return From Subroutine	RTS									39	5 1			•	•	•	•	•	•
Software Interrupt	SWI									3F	12 1			•	•	•	•	•	•
Wait for Interrupt*	WAI									3E	9 1			•	•	•	•	•	•
Sleep	SLP									1A	4 1			•	•	•	•	•	•

(Note) * WAI puts R/W high; Address Bus goes to FFFF; Data Bus goes to the three state. Condition Code Register will be explained in Note of Table 13.

Table 13 Condition Code Register Manipulation Instructions

Operations	Mnemonic	AddressingModes			Boolean Operation	Condition Code Register						
		IMPLIED				5	4	3	2	1	0	
		OP	~	#								
Clear Carry	CLC	0C	1	1	0 → C	•	•	•	•	•	•	R
Clear Interrupt Mask	CLI	0E	1	1	0 → I	•	R	•	•	•	•	•
Clear Overflow	CLV	0A	1	1	0 → V	•	•	•	•	•	R	•
Set Carry	SEC	0D	1	1	1 → C	•	•	•	•	•	•	S
Set Interrupt Mask	SEI	0F	1	1	1 → I	•	S	•	•	•	•	•
Set Overflow	SEV	0B	1	1	1 → V	•	•	•	•	•	S	•
Accumulator A → CCR	TAP	06	1	1	A → CCR	10						
CCR → Accumulator A	TPA	07	1	1	CCR → A	•	•	•	•	•	•	•

LEGEND

- OP Operation Code (Hexadecimal)
- ~ Number of MCU Cycles
- M_{SP} Contents of memory location pointed to by Stack Pointer
- # Number of Program Bytes
- + Arithmetic Plus
- Arithmetic Minus
- Boolean AND
- + Boolean Inclusive OR
- ⊕ Boolean Exclusive OR
- M̄ Complement of M
- Transfer into
- 0 Bit = Zero
- 00 Byte = Zero

CONDITION CODE SYMBOLS

- H Half-carry from bit 3 to bit 4
- I Interrupt mask
- N Negative (sign bit)
- Z Zero (byte)
- V Overflow, 2's complement
- C Carry/Borrow from/to bit 7
- R Reset Always
- S Set Always
- ↓ Set if true after test or clear
- Not Affected

(Note) Condition Code Register Notes: (Bit set if test is true and cleared otherwise)

- ① (Bit V) Test: Result = 10000000?
- ② (Bit C) Test: Result ≠ 00000000?
- ③ (Bit C) Test: BCD Character of high-order byte greater than 10? (Not cleared if previously set)
- ④ (Bit V) Test: Operand = 10000000 prior to execution?
- ⑤ (Bit V) Test: Operand = 01111111 prior to execution?
- ⑥ (Bit V) Test: Set equal to N ⊕ C = 1 after the execution of instructions
- ⑦ (Bit N) Test: Result less than zero? (Bit 15=1)
- ⑧ (All Bit) Load Condition Code Register from Stack.
- ⑨ (Bit I) Set when interrupt occurs. If previously set, a Non-Maskable Interrupt is required to exist the wait state.
- ⑩ (All Bit) Set according to the contents of Accumulator A.
- ⑪ (Bit C) Result of Multiplication Bit 7=1? (ACCB)

Table 14 OP-Code Map

OP CODE					ACC A	ACC B	IND	EXT DIR	ACCA or SP				ACCB or X				
	HI	0000	0001	0010	0011	0100	0101	0110	0111	1000	1001	1010	1011	1100	1101	1110	1111
LO	0	1	2	3	4	5	6	7	8	9	A	B	C	D	E	F	
0000	0	SBA	BRA	TSX	NEG									SUB			0
0001	1	NOP	CBA	BRN	INS	AIM								CMP			1
0010	2		BHI	PULA	OIM									SBC			2
0011	3		BLS	PULB	COM					SUBD				ADD			3
0100	4	LSRD	BCC	DES	LSR									AND			4
0101	5	ASLD	BCS	TXS	EIM									BIT			5
0110	6	TAP	TAB	BNE	PSHA	ROR								LDA			6
0111	7	TPA	TBA	BEQ	PSHB	ASR				STA				STA			7
1000	8	INX	XGDX	BVC	PULX	ASL							EOR			8	
1001	9	DEX	DAA	BVS	RTS	ROL							ADC			9	
1010	A	CLV	SLP	BPL	ABX	DEC							ORA			A	
1011	B	SEV	ABA	BMI	RTI	TIM							ADD			B	
1100	C	CLC		BGE	PSHX	INC				CPX				LDD			C
1101	D	SEC		BLT	MUL	TST			BSR	JSR				STD			D
1110	E	CLI		BGT	WAI	JMP				LDS				LDX			E
1111	F	SEI		BLE	SWI	CLR				STS				STX			F

* UNDEFINED OP CODE
 * Only each instructions of AIM, OIM, EIM, TIM

■ CPU OPERATION

● CPU Instruction Flow

When operating, the CPU fetches an instruction from a memory and executes the required function. This sequence starts with \overline{RES} cancel and repeats itself limitlessly if not affected by a special instruction or a control signal. SWI, RTI, WAI and SLP instructions are to change this operation, while \overline{NMI} , $\overline{IRQ_1}$, $\overline{IRQ_2}$, $\overline{IRQ_3}$, \overline{HALT} and \overline{STBY} are to control it. Fig. 24 gives the CPU mode transition and Fig. 25 the CPU system flow chart. Table 15 shows CPU operating states and port states.

● Operation at Each Instruction Cycle

Table 16 provides the operation at each instruction cycle. By the pipeline control of the HD6303X, MULT, PUL, DAA and XGD \overline{X} instructions etc. prefetch the next instruction. So attention is necessary to the counting of the instruction cycles because it is different from the existent one-----op code fetch to the next instruction op code.

Table 15 CPU Operation State and Port State

Port	Reset	STBY***	HALT	Sleep
A ₀ ~ A ₇	H	T	T	H
Port 2	T	T	Keep	Keep
D ₀ ~ D ₇	T	T	T	T
A ₈ ~ A ₁₅	H	T	T	H
Port 5	T	T	T	T
Port 6	T	T	Keep	Keep
Control Signal	*	T	**	*

H : High, L : Low, T : High Impedance

* \overline{RD} , \overline{WR} , R/ \overline{W} , \overline{LIR} = H, BA = L

** \overline{RD} , \overline{WR} , R/ \overline{W} = T, \overline{LIR} , BA = H

*** E pin goes to high impedance state.

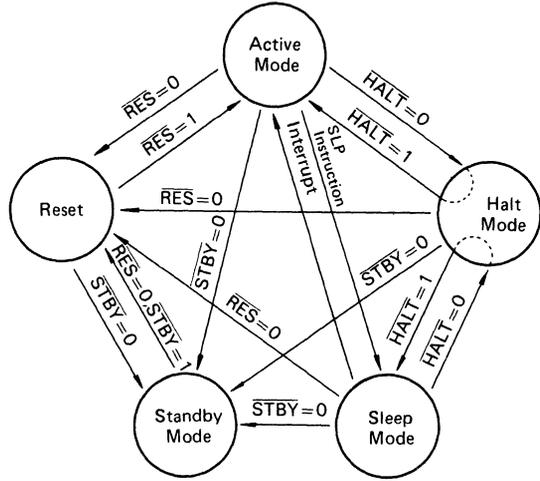


Figure 24 CPU Operation Mode Transition

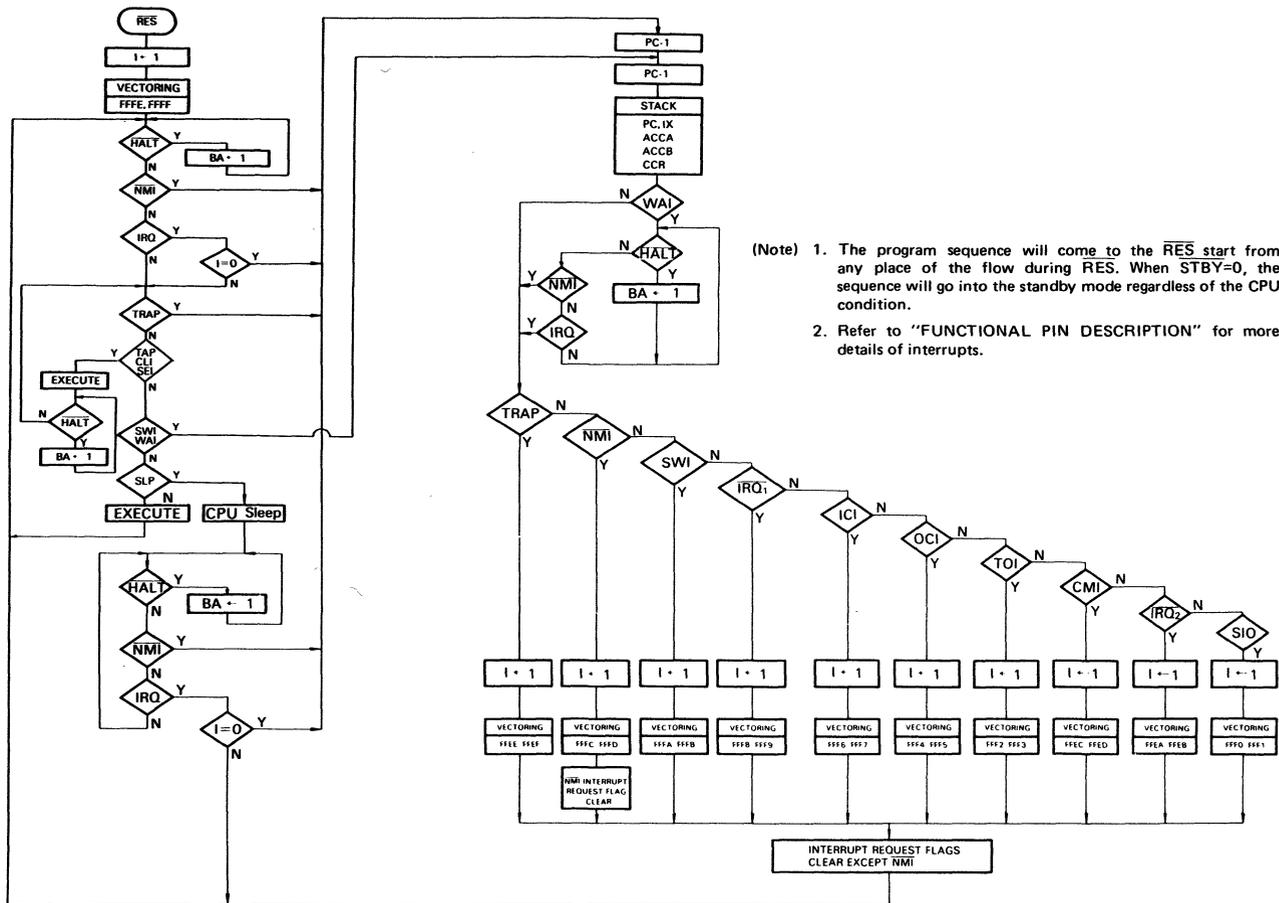


Figure 25 HD6303X System Flow Chart

Table 16 Cycle-by-Cycle Operation

Address Mode & Instructions		Cycles	Cycle =	Address Bus	R \bar{W}	$\bar{R}D$	WR	LIR	Data Bus
IMMEDIATE									
ADC	ADD	2	1	Op Code Address+1	1	0	1	1	Operand Data
AND	BIT		2	Op Code Address+2	1	0	1	0	Next Op Code
CMP	EOR								
LDA	ORA								
SBC	SUB								
ADD	CPX	3	1	Op Code Address+1	1	0	1	1	Operand Data (MSB)
LDD	LDS		2	Op Code Address+2	1	0	1	1	Operand Data (LSB)
LDX	SUBD		3	Op Code Address+3	1	0	1	0	Next Op Code
DIRECT									
ADC	ADD	3	1	Op Code Address+1	1	0	1	1	Address of Operand (LSB)
AND	BIT		2	Address of Operand	1	0	1	1	Operand Data
CMP	EOR		3	Op Code Address+2	1	0	1	0	Next Op Code
LDA	ORA								
SBC	SUB								
STA		3	1	Op Code Address+1	1	0	1	1	Destination Address
			2	Destination Address	0	1	0	1	Accumulator Data
			3	Op Code Address+2	1	0	1	0	Next Op Code
ADD	CPX	4	1	Op Code Address+1	1	0	1	1	Address of Operand (LSB)
LDD	LDS		2	Address of Operand	1	0	1	1	Operand Data (MSB)
LDX	SUBD		3	Address of Operand+1	1	0	1	1	Operand Data (LSB)
			4	Op Code Address+2	1	0	1	0	Next Op Code
STD	STS	4	1	Op Code Address+1	1	0	1	1	Destination Address (LSB)
STX			2	Destination Address	0	1	0	1	Register Data (MSB)
			3	Destination Address+1	0	1	0	1	Register Data (LSB)
			4	Op Code Address+2	1	0	1	0	Next Op Code
JSR		5	1	Op Code Address+1	1	0	1	1	Jump Address (LSB)
			2	FFFF	1	1	1	1	Restart Address (LSB)
			3	Stack Pointer	0	1	0	1	Return Address (LSB)
			4	Stack Pointer-1	0	1	0	1	Return Address (MSB)
			5	Jump Address	1	0	1	0	First Subroutine Op Code
TIM		4	1	Op Code Address+1	1	0	1	1	Immediate Data
			2	Op Code Address+2	1	0	1	1	Address of Operand (LSB)
			3	Address of Operand	1	0	1	1	Operand Data
			4	Op Code Address+3	1	0	1	0	Next Op Code
AIM	EIM	6	1	Op Code Address+1	1	0	1	1	Immediate Data
OIM			2	Op Code Address+2	1	0	1	1	Address of Operand (LSB)
			3	Address of Operand	1	0	1	1	Operand Data
			4	FFFF	1	1	1	1	Restart Address (LSB)
			5	Address of Operand	0	1	0	1	New Operand Data
			6	Op Code Address+3	1	0	1	0	Next Op Code

(Continued)

Address Mode & Instructions		Cycles	Cycle #	Address Bus	R/W	RD	WR	LIR	Data Bus
INDEXED									
JMP		3	1	Op Code Address+1	1	0	1	1	Offset
			2	FFFF	1	1	1	1	Restart Address (LSB)
			3	Jump Address	1	0	1	0	First Op Code of Jump Routine
ADC	ADD	4	1	Op Code Address+1	1	0	1	1	Offset
AND	BIT		2	FFFF	1	1	1	1	Restart Address (LSB)
CMP	EOR		3	IX+Offset	1	0	1	1	Operand Data
LDA	ORA		4	Op Code Address+2	1	0	1	0	Next Op Code
SBC	SUB								
STA		4	1	Op Code Address+1	1	0	1	1	Offset
			2	FFFF	1	1	1	1	Restart Address (LSB)
			3	IX+Offset	0	1	0	1	Accumulator Data
			4	Op Code Address+2	1	0	1	0	Next Op Code
ADD	LDD	5	1	Op Code Address+1	1	0	1	1	Offset
CPX	LDS		2	FFFF	1	1	1	1	Restart Address (LSB)
LDS	LDX		3	IX+Offset	1	0	1	1	Operand Data (MSB)
SUBD			4	IX+Offset+1	1	0	1	1	Operand Data (LSB)
			5	Op Code Address+2	1	0	1	0	Next Op Code
STD	STS	5	1	Op Code Address+1	1	0	1	1	Offset
STX			2	FFFF	1	1	1	1	Restart Address (LSB)
			3	IX+Offset	0	1	0	1	Register Data (MSB)
			4	IX+Offset+1	0	1	0	1	Register Data (LSB)
			5	Op Code Address+2	1	0	1	0	Next Op Code
JSR		5	1	Op Code Address+1	1	0	1	1	Offset
			2	FFFF	1	1	1	1	Restart Address (LSB)
			3	Stack Pointer	0	1	0	1	Return Address (LSB)
			4	Stack Pointer-1	0	1	0	1	Return Address (MSB)
			5	IX+Offset	1	0	1	0	First Subroutine Op Code
ASL	ASR	6	1	Op Code Address+1	1	0	1	1	Offset
COM	DEC		2	FFFF	1	1	1	1	Restart Address (LSB)
INC	LSR		3	IX+Offset	1	0	1	1	Operand Data
NEG	ROL		4	FFFF	1	1	1	1	Restart Address (LSB)
ROR			5	IX+Offset	0	1	0	1	New Operand Data
			6	Op Code Address+1	1	0	1	0	Next Op Code
TIM		5	1	Op Code Address+1	1	0	1	1	Immediate Data
			2	Op Code Address+2	1	0	1	1	Offset
			3	FFFF	1	1	1	1	Restart Address (LSB)
			4	IX+Offset	1	0	1	1	Operand Data
			5	Op Code Address+3	1	0	1	0	Next Op Code
CLR		5	1	Op Code Address+1	1	0	1	1	Offset
			2	FFFF	1	1	1	1	Restart Address (LSB)
			3	IX+Offset	1	0	1	1	Operand Data
			4	IX+Offset	0	1	0	1	OO
			5	Op Code Address+2	1	0	1	0	Next Op Code
AIM	EIM	7	1	Op Code Address+1	1	0	1	1	Immediate Data
OIM			2	Op Code Address+2	1	0	1	1	Offset
			3	FFFF	1	1	1	1	Restart Address (LSB)
			4	IX+Offset	1	0	1	1	Operand Data
			5	FFFF	1	1	1	1	Restart Address (LSB)
			6	IX+Offset	0	1	0	1	New Operand Data
			7	Op Code Address+3	1	0	1	0	Next Op Code

(Continued)

Address Mode & Instructions	Cycles	Cycle #	Address Bus	R	W	RD	WR	LIR	Data Bus
EXTEND									
JMP	3	1	Op Code Address + 1	1	0	1	1		Jump Address (MSB)
		2	Op Code Address + 2	1	0	1	1		Jump Address (LSB)
		3	Jump Address	1	0	1	0		Next Op Code
ADC ADD TST AND BIT CMP EOR LDA ORA SBC SUB	4	1	Op Code Address + 1	1	0	1	1		Address of Operand (MSB)
		2	Op Code Address + 2	1	0	1	1		Address of Operand (LSB)
		3	Address of Operand	1	0	1	1		Operand Data
		4	Op Code Address + 3	1	0	1	0		Next Op Code
STA	4	1	Op Code Address + 1	1	0	1	1		Destination Address (MSB)
		2	Op Code Address + 2	1	0	1	1		Destination Address (LSB)
		3	Destination Address	0	1	0	1		Accumulator Data
		4	Op Code Address + 3	1	0	1	0		Next Op Code
ADDD CPX LDD LDS LDX SUBD	5	1	Op Code Address + 1	1	0	1	1		Address of Operand (MSB)
		2	Op Code Address + 2	1	0	1	1		Address of Operand (LSB)
		3	Address of Operand	1	0	1	1		Operand Data (MSB)
		4	Address of Operand + 1	1	0	1	1		Operand Data (LSB)
		5	Op Code Address + 3	1	0	1	0		Next Op Code
STD STS STX	5	1	Op Code Address + 1	1	0	1	1		Destination Address (MSB)
		2	Op Code Address + 2	1	0	1	1		Destination Address (LSB)
		3	Destination Address	0	1	0	1		Register Data (MSB)
		4	Destination Address + 1	0	1	0	1		Register Data (LSB)
		5	Op Code Address + 3	1	0	1	0		Next Op Code
JSR	6	1	Op Code Address + 1	1	0	1	1		Jump Address (MSB)
		2	Op Code Address + 2	1	0	1	1		Jump Address (LSB)
		3	FFFF	1	1	1	1		Restart Address (LSB)
		4	Stack Pointer	0	1	0	1		Return Address (LSB)
		5	Stack Pointer - 1	0	1	0	1		Return Address (MSB)
		6	Jump Address	1	0	1	0		First Subroutine Op Code
ASL ASR COM DEC INC LSR NEG ROL ROR	6	1	Op Code Address + 1	1	0	1	1		Address of Operand (MSB)
		2	Op Code Address + 2	1	0	1	1		Address of Operand (LSB)
		3	Address of Operand	1	0	1	1		Operand Data
		4	FFFF	1	1	1	1		Restart Address (LSB)
		5	Address of Operand	0	1	0	1		New Operand Data
		6	Op Code Address + 3	1	0	1	0		Next Op Code
CLR	5	1	Op Code Address + 1	1	0	1	1		Address of Operand (MSB)
		2	Op Code Address + 2	1	0	1	1		Address of Operand (LSB)
		3	Address of Operand	1	0	1	1		Operand Data
		4	Address of Operand	0	1	0	1		00
		5	Op Code Address + 3	1	0	1	0		Next Op Code

(Continued)

Address Mode & Instructions		Cycles	Cycle #	Address Bus	R/W	\overline{RD}	\overline{WR}	\overline{LIR}	Data Bus
IMPLIED									
ABA	ABX		1	Op Code Address+1	1	0	1	0	Next Op Code
ASL	ASLD								
ASR	CBA								
CLC	CLI								
CLR	CLV								
COM	DEC								
DES	DEX								
INC	INS								
INX	LSR	1							
LSRD	R0L								
ROR	NOP								
SBA	SEC								
SEI	SEV								
TAB	TAP								
TBA	TPA								
TST	TSX								
TXS									
DAA	XGDX	2	1	Op Code Address+1	1	0	1	0	Next Op Code
			2	FFFF	1	1	1	1	Restart Address (LSB)
PULA	PULB	3	1	Op Code Address+1	1	0	1	0	Next Op Code
			2	FFFF	1	1	1	1	Restart Address (LSB)
			3	Stack Pointer+1	1	0	1	1	Data from Stack
PSHA	PSHB	4	1	Op Code Address+1	1	0	1	1	Next Op Code
			2	FFFF	1	1	1	1	Restart Address (LSB)
			3	Stack Pointer	0	1	0	1	Accumulator Data
			4	Op Code Address+1	1	0	1	0	Next Op Code
PULX		4	1	Op Code Address+1	1	0	1	0	Next Op Code
			2	FFFF	1	1	1	1	Restart Address (LSB)
			3	Stack Pointer+1	1	0	1	1	Data from Stack (MSB)
			4	Stack Pointer+2	1	0	1	1	Data from Stack (LSB)
PSHX		5	1	Op Code Address+1	1	0	1	1	Next Op Code
			2	FFFF	1	1	1	1	Restart Address (LSB)
			3	Stack Pointer	0	1	0	1	Index Register (LSB)
			4	Stack Pointer-1	0	1	0	1	Index Register (MSB)
			5	Op Code Address+1	1	0	1	0	Next Op Code
RTS		5	1	Op Code Address+1	1	0	1	1	Next Op Code
			2	FFFF	1	1	1	1	Restart Address (LSB)
			3	Stack Pointer+1	1	0	1	1	Return Address (MSB)
			4	Stack Pointer+2	1	0	1	1	Return Address (LSB)
			5	Return Address	1	0	1	0	First Op Code of Return Routine
MUL		7	1	Op Code Address+1	1	0	1	0	Next Op Code
			2	FFFF	1	1	1	1	Restart Address (LSB)
			3	FFFF	1	1	1	1	Restart Address (LSB)
			4	FFFF	1	1	1	1	Restart Address (LSB)
			5	FFFF	1	1	1	1	Restart Address (LSB)
			6	FFFF	1	1	1	1	Restart Address (LSB)
			7	FFFF	1	1	1	1	Restart Address (LSB)

(Continued)

Address Mode & Instructions		Cycles	Cycle #	Address Bus	R/W	RD	WR	LIR	Data Bus
IMPLIED									
WAI		9	1	Op Code Address+1	1	0	1	1	Next Op Code
			2	FFFF	1	1	1	1	Restart Address (LSB)
			3	Stack Pointer	0	1	0	1	Return Address (LSB)
			4	Stack Pointer-1	0	1	0	1	Return Address (MSB)
			5	Stack Pointer-2	0	1	0	1	Index Register (LSB)
			6	Stack Pointer-3	0	1	0	1	Index Register (MSB)
			7	Stack Pointer-4	0	1	0	1	Accumulator A
			8	Stack Pointer-5	0	1	0	1	Accumulator B
			9	Stack Pointer-6	0	1	0	1	Conditional Code Register
RTI		10	1	Op Code Address+1	1	0	1	1	Next Op Code
			2	FFFF	1	1	1	1	Restart Address (LSB)
			3	Stack Pointer+1	1	0	1	1	Conditional Code Register
			4	Stack Pointer+2	1	0	1	1	Accumulator B
			5	Stack Pointer+3	1	0	1	1	Accumulator A
			6	Stack Pointer+4	1	0	1	1	Index Register (MSB)
			7	Stack Pointer+5	1	0	1	1	Index Register (LSB)
			8	Stack Pointer+6	1	0	1	1	Return Address (MSB)
			9	Stack Pointer+7	1	0	1	1	Return Address (LSB)
			10	Return Address	1	0	1	0	First Op Code of Return Routine
SWI		12	1	Op Code Address+1	1	0	1	1	Next Op Code
			2	FFFF	1	1	1	1	Restart Address (LSB)
			3	Stack Pointer	0	1	0	1	Return Address (LSB)
			4	Stack Pointer-1	0	1	0	1	Return Address (MSB)
			5	Stack Pointer-2	0	1	0	1	Index Register (LSB)
			6	Stack Pointer-3	0	1	0	1	Index Register (MSB)
			7	Stack Pointer-4	0	1	0	1	Accumulator A
			8	Stack Pointer-5	0	1	0	1	Accumulator B
			9	Stack Pointer-6	0	1	0	1	Conditional Code Register
			10	Vector Address FFFA	1	0	1	1	Address of SWI Routine (MSB)
			11	Vector Address FFFB	1	0	1	1	Address of SWI Routine (LSB)
			12	Address of SWI Routine	1	0	1	0	First Op Code of SWI Routine
SLP		4	1	Op Code Address+1	1	0	1	1	Next Op Code
			2	FFFF	1	1	1	1	Restart Address (LSB)
			3	FFFF	1	1	1	1	Restart Address (LSB)
			4	Op Code Address+1	1	0	1	0	Next Op Code
RELATIVE									
BCC BCS BEQ BGE BGT BHI BLE BLS BLT BMT BNE BPL BRA BRN BVC BVS		3	1	Op Code Address+1	1	0	1	1	Branch Offset
			2	FFFF	1	1	1	1	Restart Address (LSB)
			3	Branch Address: ...Test="1"	1	0	1	0	First Op Code of Branch Routine
			Op Code Address+1...Test="0"	1	0	1	0	Next Op Code	
			BSR	1	Op Code Address+1	1	0	1	1
BSR		5	2	FFFF	1	1	1	1	Restart Address (LSB)
			3	Stack Pointer	0	1	0	1	Return Address (LSB)
			4	Stack Pointer-1	0	1	0	1	Return Address (MSB)
			5	Branch Address	1	0	1	0	First Op Code of Subroutine

HD6303Y, HD63A03Y, HD63B03Y CMOS MPU (Micro Processing Unit)

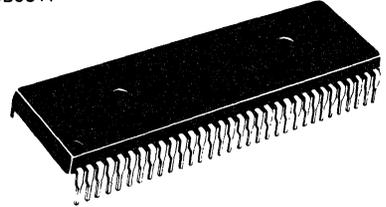
The HD6303Y is a CMOS 8-bit micro processing unit which contains a CPU compatible with the HD6301V1, 256 bytes of RAM, 24 parallel I/O Pins, Serial Communication Interface (SCI) and two timers.

■ FEATURES

- Instruction Set Compatible with the HD6301 Family
- Abundant On-chip Resources
 - 256 Bytes of RAM
 - 24 Parallel I/O Pins
 - Handshake Interface (Port 6)
 - Darlington Transistor Direct Drive (Port 2, 6)
 - 16-bit Programmable Timer
 - (1 Input Capture Register
 - 1 Free Running Counter
 - 2 Output Compare Registers
 - 8-Bit Reloadable Timer
 - (1 8-bit Up Counter
 - 1 Time Constant Register
- Serial Communication Interface
 - Asynchronous Mode
 - (8 Transmit Formats
 - Hardware Parity
 - Clocked Synchronous Mode
- Interrupt – 3 External, 7 Internal
- CPU Functions
 - Memory Ready, Auto Memory Ready
 - Halt
 - Error Detection (Address Trap, Op-code Trap)
- Up to 65k Bytes Address Space
- Low Power Dissipation Mode
 - Sleep
 - Standby (Hardware Set, Software Set)
- Wide Range of Operation
 - $V_{CC} = 3 \text{ to } 6 \text{ V}$ ($f = 0.1 \text{ to } 0.5 \text{ MHz}$)
 - $V_{CC} = 5 \text{ V} \pm 10\%$
 - ($f = 0.1 \text{ to } 1.0 \text{ MHz}$; HD6303Y)
 - ($f = 0.1 \text{ to } 1.5 \text{ MHz}$; HD63A03Y)
 - ($f = 0.1 \text{ to } 2.0 \text{ MHz}$; HD63B03Y)
- Minimum Instruction Cycle Time: $0.5 \mu\text{s}$ ($f = 2.0 \text{ MHz}$)

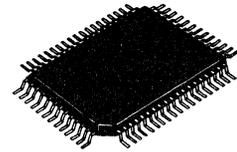
—ADVANCE INFORMATION—

HD6303YP, HD63A03YP,
HD63B03YP



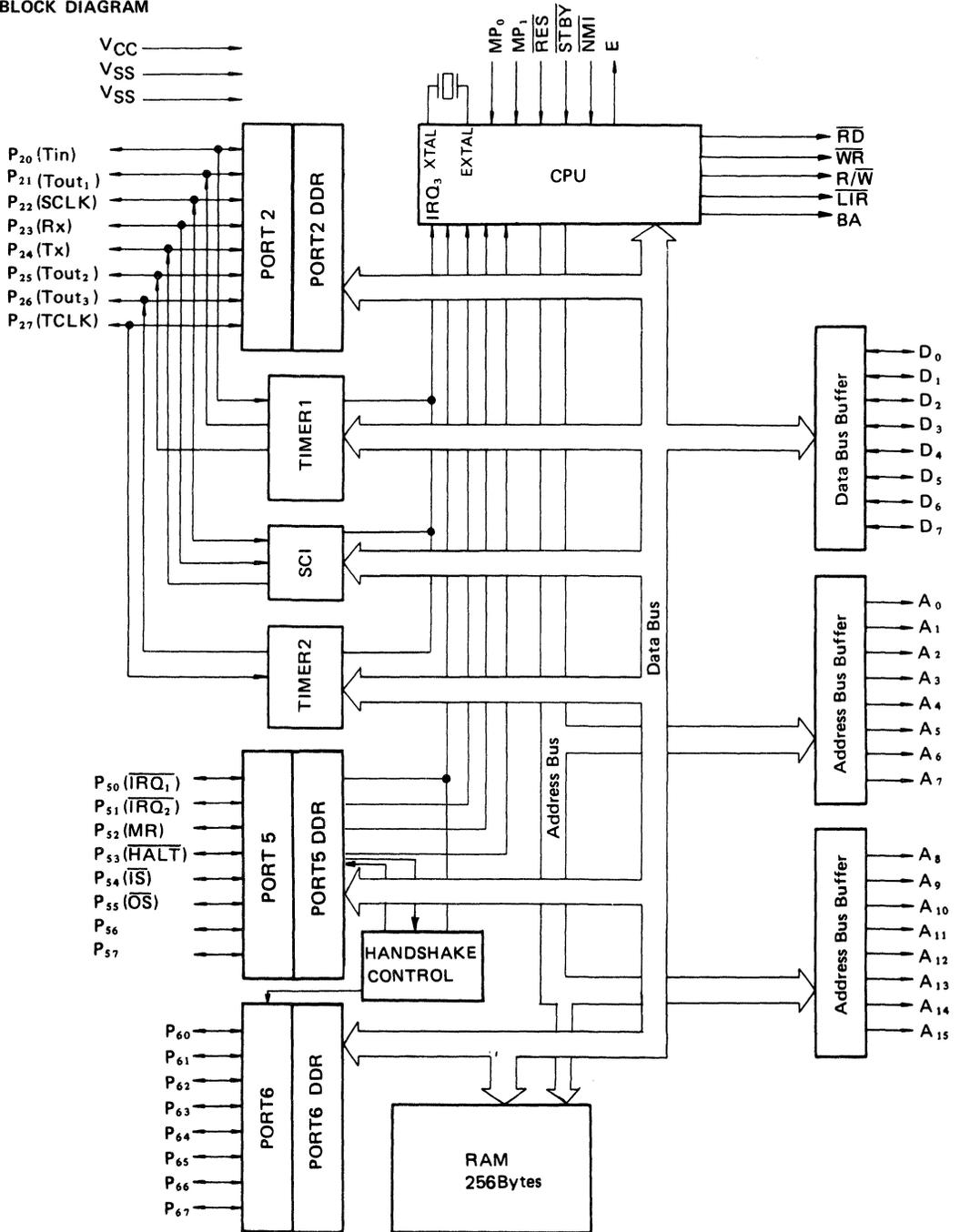
(DP-64S)

HD6303YF, HD63A03YF,
HD63B03YF



(FP-64)

■ BLOCK DIAGRAM



HD6305X2, HD63A05X2, HD63B05X2

CMOS MPU (Micro Processing Unit)

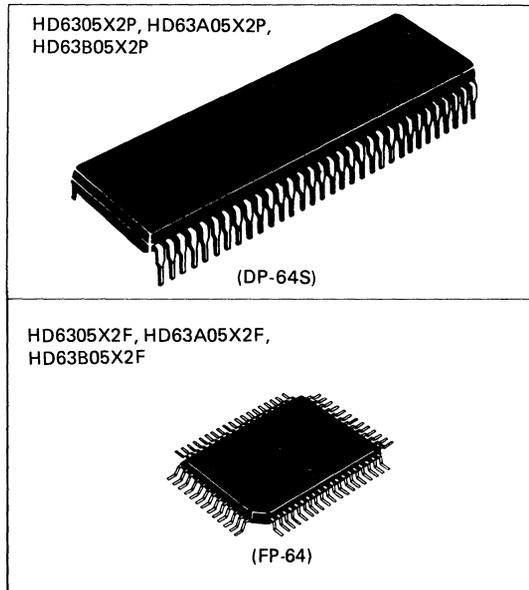
—PRELIMINARY—

The HD6305X2 is a CMOS 8-bit micro processing unit. A CPU, a clock generator, a 128-byte RAM, I/O terminals, two timers and a serial communication interface (SCI) are built in the HD6305X2.

The HD6305X2 has the same functions as the HD6305X0's except for the number of I/O terminals. The HD6305X2 is a micro processing unit and its memory space is expandable to 16k bytes externally.

■ HARDWARE FEATURES

- 8-bit based MPU
- 128-bytes of RAM
- A total of 31 terminals, including 24 I/O's, 7 inputs
- Two timers
 - 8-bit timer with a 7-bit prescaler (programmable prescaler; event counter)
 - 15-bit timer (commonly used with the SCI clock divider)
- On-chip serial interface circuit (synchronized with clock)
- Six interrupts (two external, two timer, one serial and one software)
- Low power dissipation modes
 - Wait In this mode, the clock oscillator is on and the CPU halts but the timer/serial/interrupt function is operatable.
 - Stop In this mode, the clock stops but the RAM data, I/O status and registers are held.
 - Standby . . In this mode, the clock stops, the RAM data is held, and the other internal condition is reset.
- Minimum instruction cycle time
 - HD6305X2 1 μ s ($f = 1$ MHz)
 - HD63A05X2 0.67 μ s ($f = 1.5$ MHz)
 - HD63B05X2 0.5 μ s ($f = 2$ MHz)
- Wide operating range
 - $V_{CC} = 3$ to 6V ($f = 0.1$ to 0.5 MHz)
 - HD6305X2 $f = 0.1$ to 1 MHz ($V_{CC} = 5V \pm 10\%$)
 - HD63A05X2 $f = 0.1$ to 1.5 MHz ($V_{CC} = 5V \pm 10\%$)
 - HD63B05X2 $f = 0.1$ to 2 MHz ($V_{CC} = 5V \pm 10\%$)
- System development fully supported by an evaluation kit

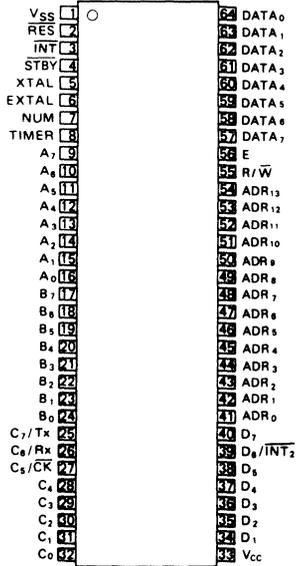


■ SOFTWARE FEATURES

- Similar to HD6800
- Byte efficient instruction set
- Powerful bit manipulation instructions (Bit Set, Bit Clear, and Bit Test and Branch usable for all RAM bits and all I/O terminals)
- A variety of interrupt operations
- Index addressing mode useful for table processing
- A variety of conditional branch instructions
- Ten powerful addressing modes
- All addressing modes adaptable to RAM, and I/O instructions
- Three new instructions, STOP, WAIT and DAA, added to the HD6805 family instruction set
- Instructions that are upward compatible with those of Motorola's MC6805P2 and MC146805G2

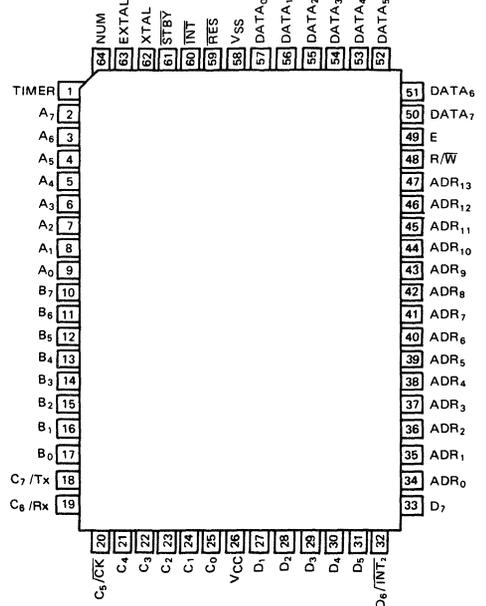
■ PIN ARRANGEMENT

● HD6305X2P, HD63A05X2P, HD63B05X2P



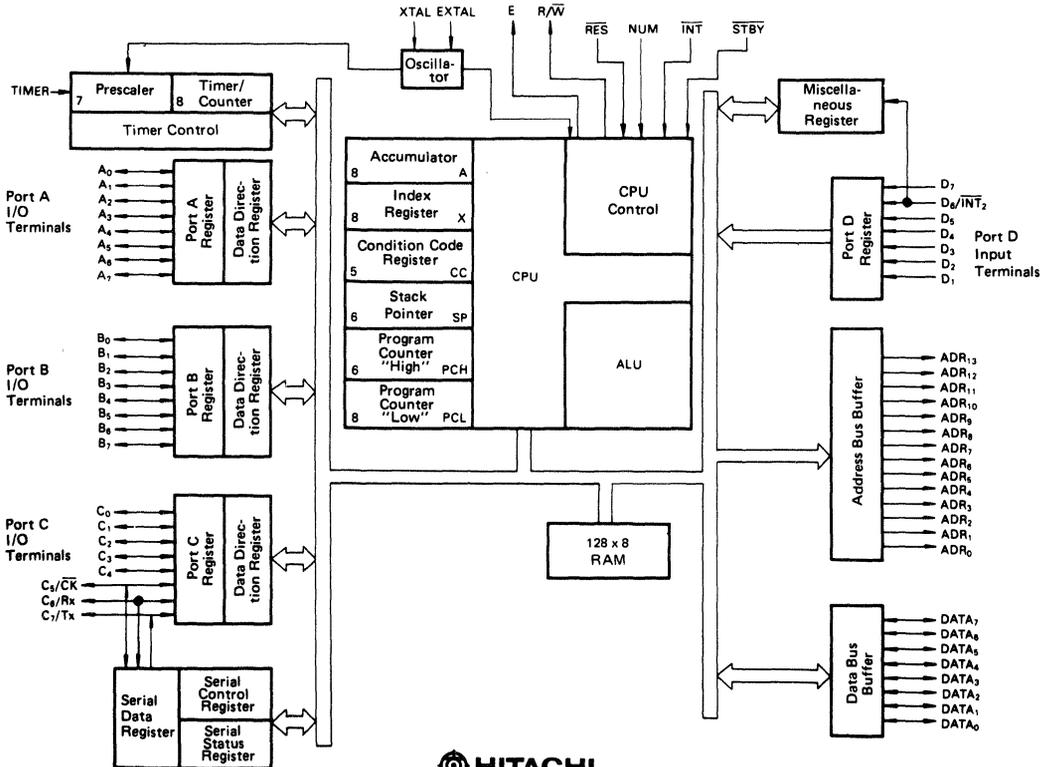
(Top View)

● HD6305X2F, HD63A05X2F, HD63B05X2F



(Top View)

■ BLOCK DIAGRAM



■ ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Value	Unit
Supply Voltage	V _{CC}	-0.3 ~ +7.0	V
Input Voltage	V _{in}	-0.3 ~ V _{CC} + 0.3	V
Operating Temperature	T _{opr}	0 ~ +70	°C
Storage Temperature	T _{stg}	-55 ~ +150	°C

[NOTE] These products have a protection circuit in their input terminals against high electrostatic voltage or high electric fields. Notwithstanding, be careful not to apply any voltage higher than the absolute maximum rating to these high input impedance circuits. To assure normal operation, we recommended V_{in}, V_{out}, V_{SS} ≤ (V_{in} or V_{out}) ≤ V_{CC}.

■ ELECTRICAL CHARACTERISTICS

● DC CHARACTERISTICS (V_{CC} = 5.0V ± 10%, V_{SS} = 0V, Ta = 0 ~ +70°C, unless otherwise noted.)

Item	Symbol	Test Condition	min	typ	max	Unit	
Input "High" Voltage	RES, STBY	V _{IH}	V _{CC} -0.5	—	V _{CC} +0.3	V	
	EXTAL		V _{CC} x0.7	—	V _{CC} +0.3		
	Other Inputs		2.0	—	V _{CC} +0.3		
Input "Low" Voltage	All Inputs	V _{IL}	-0.3	—	0.8	V	
Output "High" Voltage	All Outputs	V _{OH}	I _{OH} = -200μA	2.4	—	V	
			I _{OH} = -10μA	V _{CC} -0.7	—		—
Output "Low" Voltage	All Outputs	V _{OL}	I _{OL} = 1.6mA	—	0.55	V	
Input Leakage Current	TIMER, INT, D ₁ ~ D ₇ , STBY	I _{IL}	—	—	1.0	μA	
Three-state Current	A ₀ ~ A ₇ , B ₀ ~ B ₇ , C ₀ ~ C ₇ , ADR ₀ ~ ADR ₁₃ *, E*, R/W*	I _{TSI}	Vin = 0.5 ~ V _{CC} -0.5	—	1.0	μA	
Current Dissipation**	Operating	I _{CC}	f = 1MHz***	—	5	10	mA
	Wait			—	2	5	mA
	Stop			—	2	10	μA
	Standby			—	2	10	μA
Input Capacitance	All Terminals	Cin	f = 1MHz, Vin = 0V	—	—	12	pF

* Only at standby

** V_{IH} min = V_{CC}-1.0V, V_{IL} max = 0.8V

*** The value at f = xMHz is given by using.

I_{CC} (f = xMHz) = I_{CC} (f = 1MHz) x x

● AC CHARACTERISTICS (V_{CC} = 5.0V ± 10%, V_{SS} = 0V, Ta = 0 ~ +70°C, unless otherwise noted.)

Item	Symbol	Test Condition	HD6305X2			HD63A05X2			HD63B05X2			Unit
			min	typ	max	min	typ	max	min	typ	max	
Cycle Time	t _{cyc}	Fig. 1	1	—	10	0.666	—	10	0.5	—	10	μs
Enable Rise Time	t _{Er}		—	—	20	—	—	20	—	—	20	ns
Enable Fall Time	t _{Ef}		—	—	20	—	—	20	—	—	20	ns
Enable Pulse Width("High" Level)	PW _{EH}		450	—	—	300	—	—	220	—	—	ns
Enable Pulse Width("Low" Level)	PW _{EL}		450	—	—	300	—	—	220	—	—	ns
Address Delay Time	t _{AD}		—	—	250	—	—	190	—	—	TBD	ns
Address Hold Time	t _{AH}		20	—	—	20	—	—	20	—	—	ns
Data Delay Time	t _{DW}		—	—	250	—	—	160	—	—	TBD	ns
Data Hold Time (Write)	t _{HW}		20	—	—	20	—	—	20	—	—	ns
Data Set-up Time (Read)	t _{DSR}		80	—	—	60	—	—	TBD	—	—	ns
Data Hold Time (Read)	t _{HR}		0	—	—	0	—	—	0	—	—	ns

● **PORT TIMING** ($V_{CC} = 5.0V \pm 10\%$, $V_{SS} = 0V$, $T_a = 0 \sim +70^\circ C$, unless otherwise noted.)

Item	Symbol	Test Condition	HD6305X2			HD63A05X2			HD63B05X2			Unit
			min	typ	max	min	typ	max	min	typ	max	
Port Data Set-up Time (Port A, B, C, D)	t_{PDS}	Fig. 2	200	—	—	200	—	—	200	—	—	ns
Port Data Hold Time (Port A, B, C, D)	t_{PDH}		200	—	—	200	—	—	200	—	—	ns
Port Data Delay Time (Port A, B, C)	t_{PDW}	Fig. 3	—	—	300	—	—	300	—	—	300	ns

● **CONTROL SIGNAL TIMING** ($V_{CC} = 5.0V \pm 10\%$, $V_{SS} = 0V$, $T_a = 0 \sim +70^\circ C$, unless otherwise noted.)

Item	Symbol	Test Condition	HD6305X2			HD63A05X2			HD63B05X2			Unit
			min	typ	max	min	typ	max	min	typ	max	
INT Pulse Width	t_{IWL}		$t_{cyc} + 250$	—	—	$t_{cyc} + 200$	—	—	$t_{cyc} + 200$	—	—	ns
INT ₂ Pulse Width	t_{IWL2}		$t_{cyc} + 250$	—	—	$t_{cyc} + 200$	—	—	$t_{cyc} + 200$	—	—	ns
RES Pulse Width	t_{RWL}		5	—	—	5	—	—	5	—	—	t_{cyc}
Control Set-up Time	t_{CS}	Fig. 5	250	—	—	250	—	—	250	—	—	ns
Timer Pulse Width	t_{TWL}		$t_{cyc} + 250$	—	—	$t_{cyc} + 200$	—	—	$t_{cyc} + 200$	—	—	ns
Oscillation Start Time (Crystal)	t_{OSC}	Fig.5, Fig.20*	—	—	20	—	—	20	—	—	20	ms
Reset Delay Time	t_{RHL}	Fig. 19	80	—	—	80	—	—	80	—	—	ms

* $C_L = 22pF \pm 20\%$, $R_s = 60\Omega$ max.

● **SCI TIMING** ($V_{CC} = 5.0V \pm 10\%$, $V_{SS} = 0V$, $T_a = 0 \sim +70^\circ C$, unless otherwise noted.)

Item	Symbol	Test Condition	HD6305X2			HD63A05X2			HD63B05X2			Unit
			min	typ	max	min	typ	max	min	typ	max	
Clock Cycle	t_{Scyc}	Fig. 6, Fig. 7	1	—	32768	0.67	—	21845	0.5	—	16384	μs
Data Output Delay Time	t_{TXD}		—	—	250	—	—	250	—	—	250	ns
Data Set-up Time	t_{SRX}		200	—	—	200	—	—	200	—	—	ns
Data Hold Time	t_{HRX}		100	—	—	100	—	—	100	—	—	ns

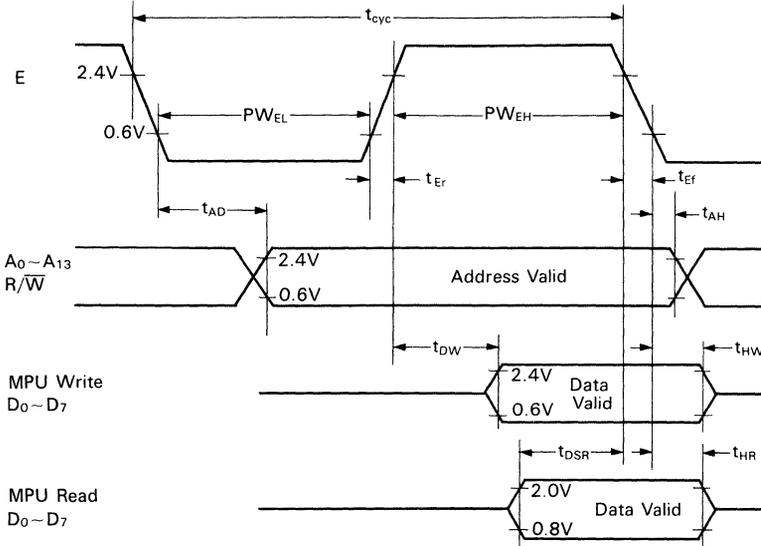


Figure 1 Bus Timing

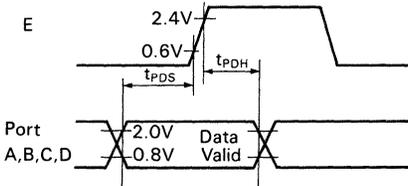


Figure 2 Port Data Set-up and Hold Times (MPU Read)

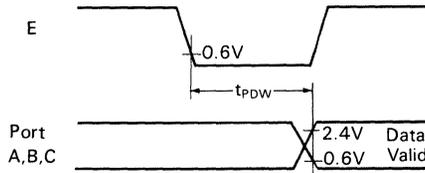


Figure 3 Port Data Delay Time (MPU Write)

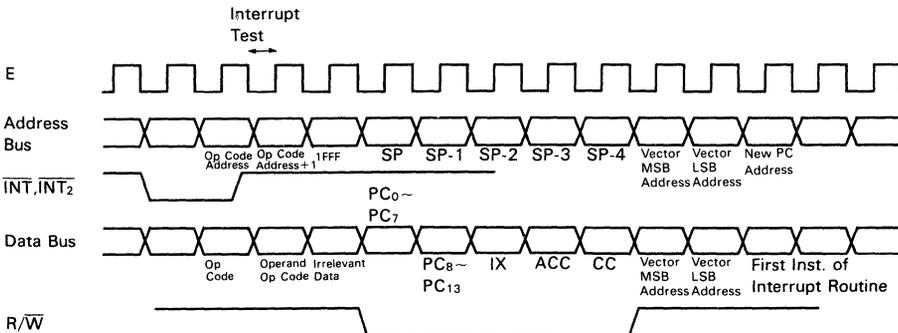


Figure 4 Interrupt Sequence

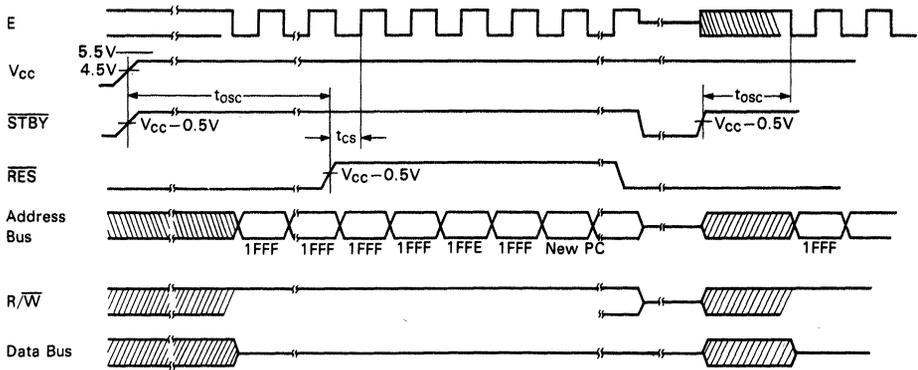


Figure 5 Reset Timing

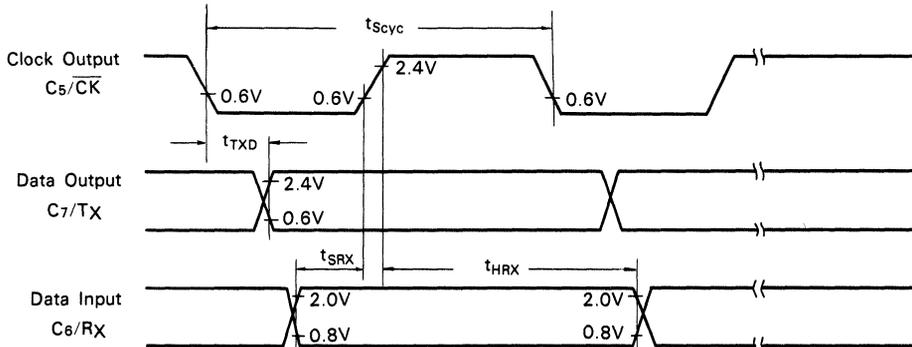


Figure 6 SCI Timing (Internal Clock)

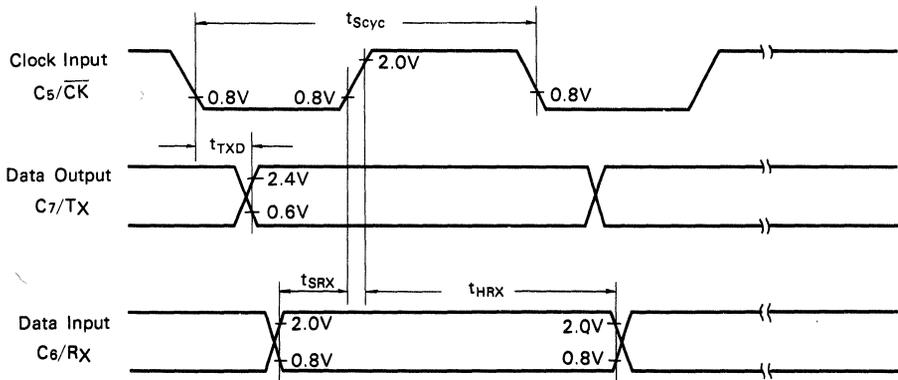
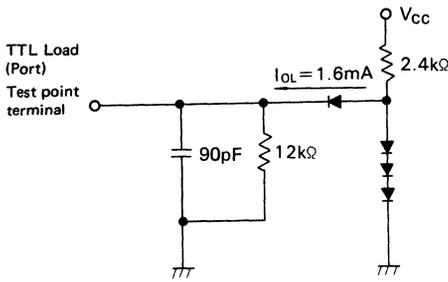


Figure 7 SCI Timing (External Clock)



- [NOTES] 1. The load capacitance includes stray capacitance caused by the probe, etc.
 2. All diodes are 1S2074 (H).

Figure 8 Test Load

■ DESCRIPTION OF TERMINAL FUNCTIONS

The input and output signals of the MPU are described here.

● V_{CC}, V_{SS}

Voltage is applied to the MPU through these two terminals. V_{CC} is 5.0V ± 10%, while V_{SS} is grounded.

● INT₁, INT₂

External interrupt request inputs to the MPU. For details, refer to "INTERRUPT". The INT₂ terminal is also used as the port D₆ terminal.

● XTAL, EXTAL

These terminals provide input to the on-chip clock circuit. A crystal oscillator (AT cut, 2.0 to 8.0 MHz) or ceramic filter is connected to the terminal. Refer to "INTERNAL OSCILLATOR" for using these input terminals.

● TIMER

This is an input terminal for event counter. Refer to "TIMER" for details.

● RES

Used to reset the MPU. Refer to "RESET" for details.

● NUM

This terminal is not for user application. This terminal should be connected to V_{SS}.

● Enable (E)

This output terminal supplies E clock. Output is a single-phase, TTL compatible and 1/4 crystal oscillation frequency or 1/4 external clock frequency. It can drive one TTL load and a 90 pF condenser.

● Read/Write (R/ \bar{W})

This TTL compatible output signal indicates to peripheral and memory devices whether MPU is in Read ("High"), or in Write ("Low"). The normal standby state is Read ("High"). Its output can drive one TTL load and a 90pF condenser.

● Data Bus (DATA₀ ~ DATA₇)

This TTL compatible three-state buffer can drive one TTL load and 90pF.

● Address Bus (ADR₀ ~ ADR₁₃)

Each terminal is TTL compatible and can drive one TTL load and 90pF.

● Input/Output Terminals (A₀ ~ A₇, B₀ ~ B₇, C₀ ~ C₇)

These 24 terminals consist of four 8-bit I/O ports (A, B, C). Each of them can be used as an input or output terminal on a bit through program control of the data direction register. For details, refer to "I/O PORTS."

● Input Terminals (D₁ ~ D₇)

These seven input-only terminals are TTL or CMOS compatible. Of the port D's, D₆ is also used as INT₂. If D₆ is used as a port, the INT₂ interrupt mask bit of the miscellaneous register must be set to "1" to prevent an INT₂ interrupt from being accidentally accepted.

● STBY

This terminal is used to place the MPU into the standby mode. With STBY at "Low" level, the oscillation stops and the internal condition is reset. For details, refer to "Standby Mode."

The terminals described in the following are I/O pins for serial communication interface (SCI). They are also used as ports C₅, C₆ and C₇. For details, refer to "SERIAL COMMUNICATION INTERFACE."

● \bar{CK} (C₅)

Used to input or output clocks for serial operation.

● Rx (C₆)

Used to receive serial data.

● Tx (C₇)

Used to transmit serial data.

■ MEMORY MAP

The memory map of the MPU is shown in Fig. 9. During interrupt processing, the contents of the CPU registers are saved into the stack in the sequence shown in Fig. 10. This saving begins with the lower byte (PCL) of the program counter. Then the value of the stack pointer is decremented and the higher byte (PCH) of the program counter, index register (X), accumulator (A) and condition code register (CC) are stacked in that order. In a subroutine call, only the contents of the program counter (PCH and PCL) are stacked.

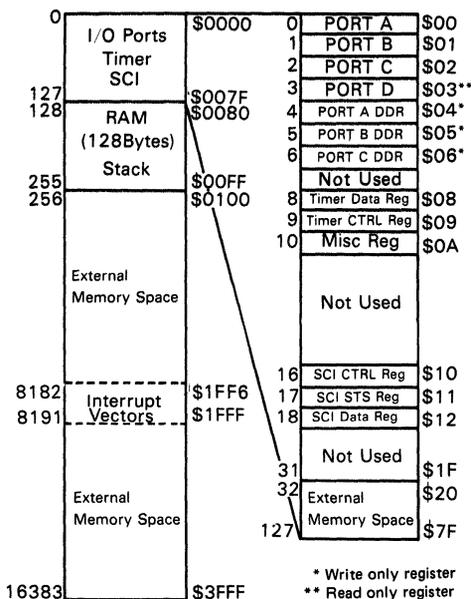
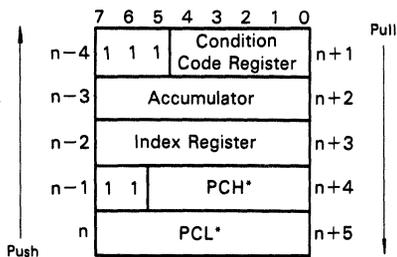


Figure 9 Memory Map of MPU



* In a subroutine call, only PCL and PCH are stacked.

Figure 10 Sequence of Interrupt Stacking

REGISTERS

There are five registers which the programmer can operate.

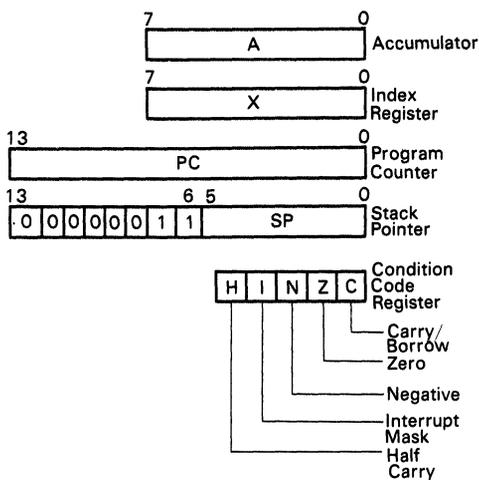


Figure 11 Programming Model

Accumulator (A)

This accumulator is an ordinary 8-bit register which holds operands or the result of arithmetic operation or data processing.

Index Register (X)

The index register is an 8-bit register, and is used for index addressing mode. Each of the addresses contained in the register consists of 8 bits which, combined with an offset value, provides an effective address.

In the case of a read/modify/write instruction, the index register can be used like an accumulator to hold operation data or the result of operation.

If not used in the index addressing mode, the register can be used to store data temporarily.

Program Counter (PC)

The program counter is a 14-bit register that contains the address of the next instruction to be executed.

Stack Pointer (SP)

The stack pointer is a 14-bit register that indicates the address of the next stacking space. Just after reset, the stack pointer is set at address \$00FF. It is decremented when data is pushed, and incremented when pulled. The upper 8 bits of the stack pointer are fixed to 00000011. During the MPU being reset or during a reset stack pointer (RSP) instruction, the pointer is set to address \$00FF. Since a subroutine or interrupt can use space up to address \$00C1 for stacking, the subroutine can be used up to 31 levels and the interrupt up to 12 levels.

Condition Code Register (CC)

The condition code register is a 5-bit register, each bit indicating the result of the instruction just executed. The bits can be individually tested by conditional branch instruc-

tions. The CC bits are as follows:

- Half Carry (H):** Used to indicate that a carry occurred between bits 3 and 4 during an arithmetic operation (ADD, ADC).
- Interrupt (I):** Setting this bit causes all interrupts, except a software interrupt, to be masked. If an interrupt occurs with the bit I set, it is latched. It will be processed the instant the interrupt mask bit is reset. (More specifically, it will enter the interrupt processing routine after the instruction following the CLI has been executed.)
- Negative (N):** Used to indicate that the result of the most recent arithmetic operation, logical operation or data processing is negative (bit 7 is logic "1").
- Zero (Z):** Used to indicate that the result of the most recent arithmetic operation, logical operation or data processing is zero.
- Carry/Borrow (C):** Represents a carry or borrow that occurred in the most recent arithmetic operation. This bit is also affected by the Bit Test and Branch instruction and a Rotate instruction.

■ INTERRUPT

There are six different types of interrupt: external interrupts (\overline{INT} , $\overline{INT_2}$), internal timer interrupts (TIMER, $TIMER_2$), serial interrupt (SCI) and interrupt by an instruction (SWI).

Of these six interrupts, the $\overline{INT_2}$ and $TIMER$ or the \overline{SCI} and $TIMER_2$ generate the same vector address, respectively.

When an interrupt occurs, the program in progress stops and the then CPU status is saved onto the stack. And then, the interrupt mask bit (I) of the condition code register is set and the start address of the interrupt processing routine is obtained from a particular interrupt vector address. Then the interrupt routine starts from the start address. System can exit from the interrupt routine by an RTI instruction. When this instruction is executed, the CPU status before the interrupt (saved onto the stack) is pulled and the CPU restarts the sequence with the instruction next to the one at which the interrupt occurred. Table 1 lists the priority of interrupts and their vector addresses.

Table 1 Priority of Interrupts

Interrupt	Priority	Vector Address
RES	1	\$1FFE, \$1FFF
SWI	2	\$1FFC, \$1FFD
\overline{INT}	3	\$1FFA, \$1FFB
TIMER/ $\overline{INT_2}$	4	\$1FF8, \$1FF9
SCI/ $TIMER_2$	5	\$1FF6, \$1FF7

A flowchart of the interrupt sequence is shown in Fig. 12. A block diagram of the interrupt request source is shown in Fig. 13.

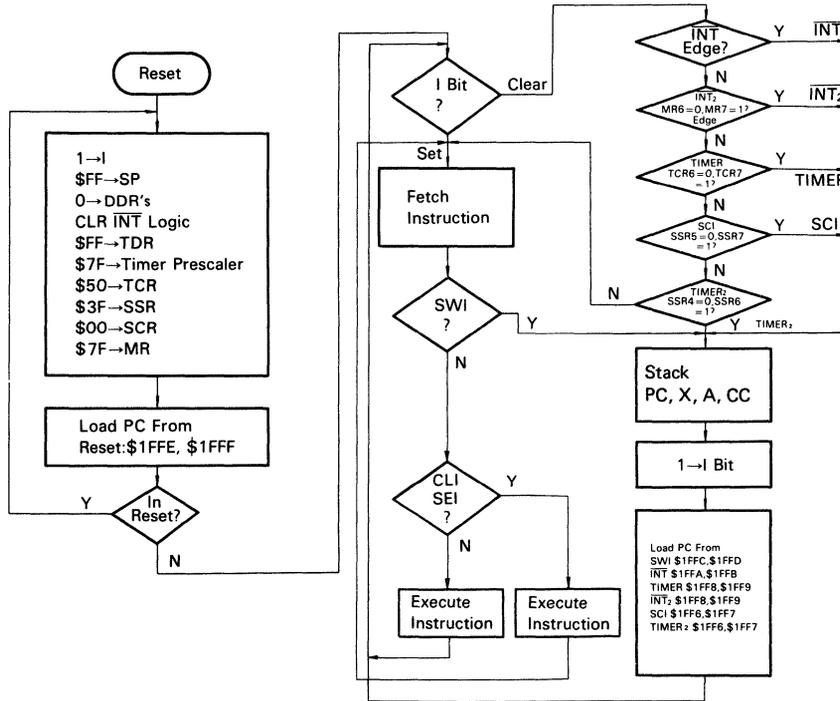


Figure 12 Interrupt Flow Chart

In the block diagram, both the external interrupts \overline{INT} and \overline{INT}_2 are edge trigger inputs. At the falling edge of each input, an interrupt request is generated and latched. The \overline{INT} interrupt request is automatically cleared if jumping is made to the \overline{INT} processing routine. Meanwhile, the \overline{INT}_2 request is cleared if "0" is written in bit 7 of the miscellaneous register.

For the external interrupts (\overline{INT} , \overline{INT}_2), internal timer interrupts (TIMER, TIMER₂) and serial interrupt (SCI), each interrupt request is held, but not processed, if the I bit of the condition code register is set. Immediately after the I bit is cleared, the corresponding interrupt processing starts according to the priority.

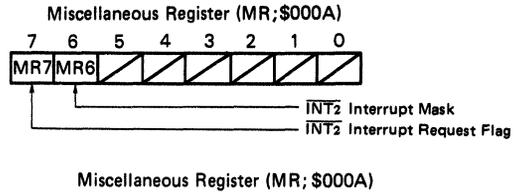
The \overline{INT}_2 interrupt can be masked by setting bit 6 of the miscellaneous register; the TIMER interrupt by setting bit 6 of the timer control register; the SCI interrupt by setting bit 5 of the serial status register; and the TIMER₂ interrupt by setting bit 4 of the serial status register.

The status of the \overline{INT} terminal can be tested by a BIL or BIH instruction. The \overline{INT} falling edge detector circuit and its latching circuit are independent of testing by these instructions. This is also true with the status of the \overline{INT}_2 terminal.

• Miscellaneous Register (MR; \$000A)

The interrupt vector address for the external interrupt \overline{INT}_2 is the same as that for the TIMER interrupt, as shown in Table 1. For this reason, a special register called the miscellaneous register (MR; \$000A) is available to control the \overline{INT}_2 interrupts.

Bit 7 of this register is the \overline{INT}_2 interrupt request flag. When the falling edge is detected at the \overline{INT}_2 terminal, "1" is set in bit 7. Then the software in the interrupt routine (vector addresses: \$1FF8, \$1FF9) checks bit 7 to see if it is \overline{INT}_2 interrupt. Bit 7 can be reset by software.



Bit 6 is the \overline{INT}_2 interrupt mask bit. If this bit is set to "1", then the \overline{INT}_2 interrupt is disabled. Both read and write are possible with bit 7 but "1" cannot be written in this bit by software. This means that an interrupt request by software is impossible.

When reset, bit 7 is cleared to "0" and bit 6 is set to "1".

■ TIMER

Figure 14 shows a MPU timer block diagram. The timer data register is loaded by software and, upon receipt of a clock input, begins to count down. When the timer data

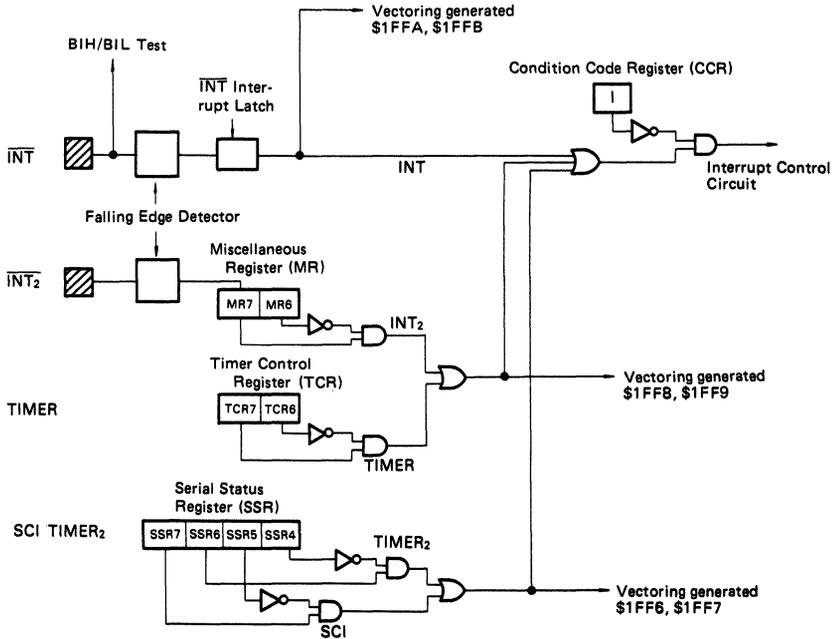


Figure 13 Interrupt Request Generation Circuitry

register (TDR) becomes "0", the timer interrupt request bit (bit 7) in the timer control register is set. In response to the interrupt request, the CPU saves its status into the stack and fetches timer interrupt routine address from addresses \$1FF8 and \$1FF9 and execute the interrupt routine. The timer interrupt can be masked by setting the timer interrupt mask bit (bit 6) in the timer control register. The mask bit (I) in the condition code register can also mask the timer interrupt.

The source clock to the timer can be either an external signal from the timer input terminal or the internal E signal (the oscillator clock divided by 4). If the E signal is used as the source, the clock input can be gated by the input to the timer input terminal.

Once the timer count has reached "0", it starts counting down with "\$FF". The count can be monitored whenever desired by reading the timer data register. This permits the program to know the length of time having passed after the occurrence of a timer interrupt, without disturbing the contents of the counter.

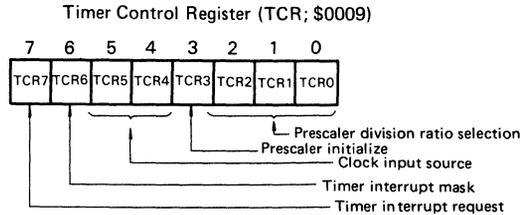
When the MPU is reset, both the prescaler and counter are initialized to logic "1". The timer interrupt request bit (bit 7) then is cleared and the timer interrupt mask bit (bit 6) is set.

To clear the timer interrupt request bit (bit 7), it is necessary to write "0" in that bit.

• **Timer Control Register (TCR; \$0009)**

Selection of a clock source, selection of a prescaler frequency division ratio, and a timer interrupt can be controlled by the timer control register (TCR; \$0009).

For the selection of a clock source, any one of the four modes (see Table 2) can be selected by bits 5 and 4 of the timer control register (TCR).



After reset, the TCR is initialized to "E under timer terminal control" (bit 5 = 0, bit 4 = 1). If the timer terminal is "1", the counter starts counting down with "\$FF" immediately after reset.

When "1" is written in bit 3, the prescaler is initialized. This bit always shows "0" when read.

Table 2 Clock Source Selection

TCR		Clock input source
Bit 5	Bit 4	
0	0	Internal clock E
0	1	E under timer terminal control
1	0	No clock input (counting stopped)
1	1	Event input from timer terminal

TCR7	Timer interrupt request
0	Absent
1	Present

TCR6	Timer interrupt mask
0	Enabled
1	Disabled

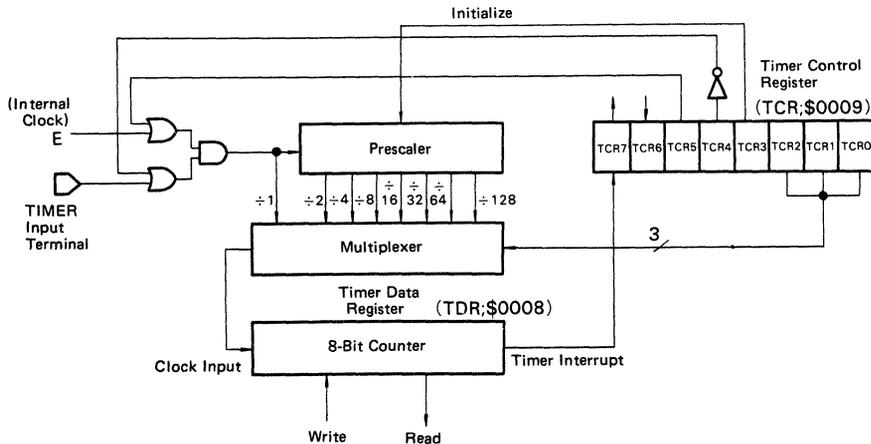


Figure 14 Timer Block Diagram

A prescaler division ratio is selected by the combination of three bits (bits 0, 1 and 2) of the timer control register (see Table 3). There are eight different division ratios: ÷1, ÷2, ÷4, ÷8, ÷16, ÷32, ÷64 and ÷128. After reset, the TCR is set to the ÷1 mode.

Table 3 Prescaler Division Ratio Selection

TCR			Prescaler division ratio
Bit 2	Bit 1	Bit 0	
0	0	0	÷1
0	0	1	÷2
0	1	0	÷4
0	1	1	÷8
1	0	0	÷16
1	0	1	÷32
1	1	0	÷64
1	1	1	÷128

A timer interrupt is enabled when the timer interrupt mask bit is "0", and disabled when the bit is "1". When a timer interrupt occurs, "1" is set in the timer interrupt request bit. This bit can be cleared by writing "0" in that bit.

■ SERIAL COMMUNICATION INTERFACE (SCI)

This interface is used for serial transmission or reception of 8-bit data. Sixteen transfer rates are available in the range from 1 μs to approx. 32 ms (for oscillation at 4 MHz).

The SCI consists of three registers, one eighth counter and one prescaler. (See Fig. 15.) SCI communicates with the CPU via the data bus, and with the outside world through bits 5, 6 and 7 of port C. Described below are the operations of each register and data transfer.

● SCI Control Register (SCR; \$0010)

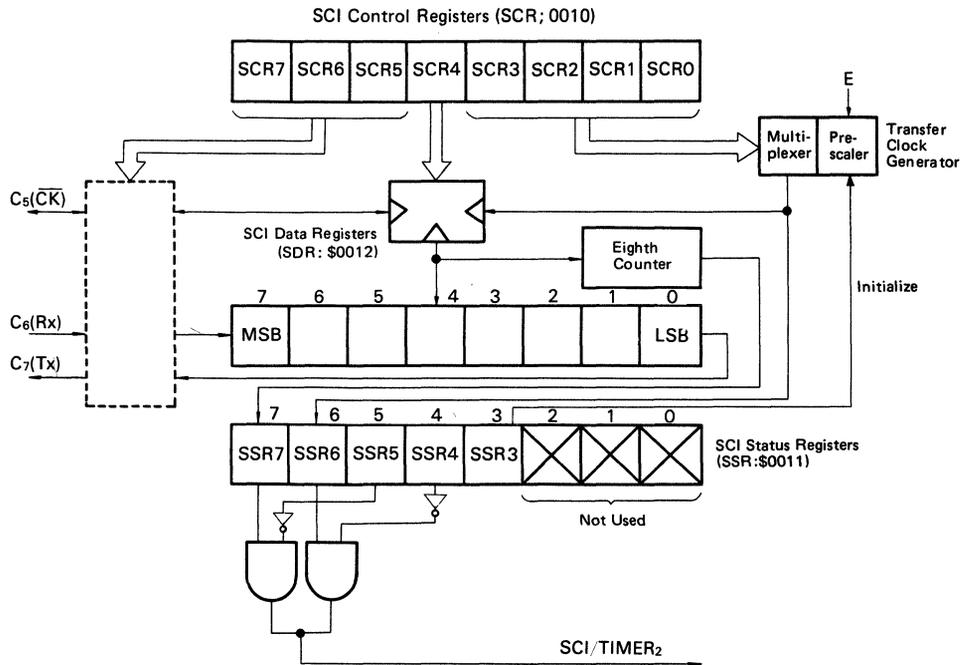
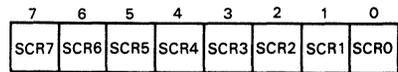


Figure 15 SCI Block Diagram

SCR7	C ₇ terminal
0	Used as I/O terminal (by DDR).
1	Serial data output (DDR output)

SCR6	C ₆ terminal
0	Used as I/O terminal (by DDR).
1	Serial data input (DDR input)

SCR5	SCR4	Clock source	C ₅ terminal
0	0	—	Used as I/O terminal (by DDR).
0	1	—	
1	0	Internal	Clock output (DDR output)
1	1	External	Clock input (DDR input)

Bit 7 (SCR7)

When this bit is set, the DDR corresponding to the C₇ becomes "1" and this terminal serves for output of SCI data. After reset, the bit is cleared to "0".

Bit 6 (SCR6)

When this bit is set, the DDR corresponding to the C₆ becomes "0" and this terminal serves for input of SCI data. After reset, the bit is cleared to "0".

Bits 5 and 4 (SCR5, SCR4)

These bits are used to select a clock source. After reset, the bits are cleared to "0".

Bits 3 ~ 0 (SCR3 ~ SCR0)

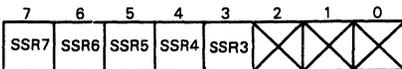
These bits are used to select a transfer clock rate. After reset, the bits are cleared to "0".

SCR3	SCR2	SCR1	SCR0	Transfer clock rate	
				4.00 MHz	4.194 MHz
0	0	0	0	1 μs	0.95 μs
0	0	0	1	2 μs	1.91 μs
0	0	1	0	4 μs	3.82 μs
0	0	1	1	8 μs	7.64 μs
?	?	?	?	?	?
1	1	1	1	32768 μs	1/32 s

•SCI Data Register (SDR; \$0012)

A serial-parallel conversion register that is used for transfer of data.

•SCI Status Register (SSR; \$0011)



Bit 7 (SSR7)

Bit 7 is the SCI interrupt request bit which is set upon completion of transmitting or receiving 8-bit data. It is cleared when reset or data is written to or read from the SCI data register with the SCR5="1". The bit can also be cleared by writing "0" in it.

Bit 6 (SSR6)

Bit 6 is the TIMER₂ interrupt request bit. TIMER₂ is used commonly with the serial clock generator, and SSR6 is set each time the internal transfer clock falls. When reset, the bit is cleared. It also be cleared by writing "0" in it. (For details, see TIMER₂.)

Bit 5 (SSR5)

Bit 5 is the SCI interrupt mask bit which can be set or cleared by software. When it is "1", the SCI interrupt (SSR7) is masked. When reset, it is set to "1".

Bit 4 (SSR4)

Bit 4 is the TIMER₂ interrupt mask bit which can be set or cleared by software. When the bit is "1", the TIMER₂ interrupt (SSR6) is masked. When reset, it is set to "1".

Bit 3 (SSR3)

When "1" is written in this bit, the prescaler of the transfer clock generator is initialized. When read, the bit always is "0".

Bits 2 ~ 0

Not used.

SSR7	SCI interrupt request
0	Absent
1	Present

SSR6	TIMER ₂ interrupt request
0	Absent
1	Present

SSR5	SCI interrupt mask
0	Enabled
1	Disabled

SSR4	TIMER ₂ interrupt mask
0	Enabled
1	Disabled

•Data Transmission

By writing the desired control bits into the SCI control registers, a transfer rate and a source of transfer clock are determined and bits 7 and 5 of port C are set at the serial data output terminal and the serial clock terminal, respectively. The transmit data should be stored from the accumulator or index register into the SCI data register. The data written in the SCI data register is output from the C₇/Tx terminal, starting with the LSB, synchronously with the falling edge of the serial clock. (See Fig. 16.) When 8 bit of

data have been transmitted, the interrupt request bit is set in bit 7 of the SCI status register with the rising edge of the last serial clock. This request can be masked by setting bit 5 of the SCI status register. Once the data has been sent, the 8th bit data (MSB) stays at the C₇/Tx terminal. If an external clock source has been selected, the transfer rate determined by bits 0 ~ 3 of the SCI control register is ignored, and the C₅/ \overline{CK} terminal is set as input. If the internal clock has been selected, the C₅/ \overline{CK} terminal is set as output and clocks are output at the transfer rate selected by bits 0 ~ 3 of the SCI control register.

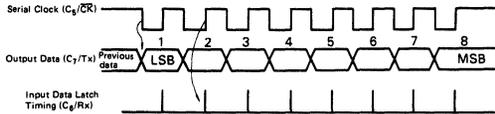


Figure 16 SCI Timing Chart

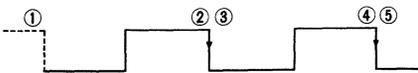
• Data Reception

By writing the desired control bits into the SCI control register, a transfer rate and a source of transfer clock are determined and bit 6 and 5 of port C are set at the serial data input terminal and the serial clock terminal, respectively. Then dummy-writing or -reading the SCI data register, the system is ready for receiving data. (This procedure is not needed after reading the subsequent received data. It must be taken after reset and after not reading the subsequent received data.)

The data from the C₆/Rx terminal is input to the SCI data register synchronously with the rising edge of the serial clock (see Fig. 16). When 8 bits of data have been received, the interrupt request bit is set in bit 7 of the SCI status register. This request can be masked by setting bit 5 of the SCI status register. If an external clock source has been selected, the transfer rate determined by bits 0 ~ 3 of the SCI control register is ignored and the data is received synchronously with the clock from the C₅/CK terminal. If the internal clock has been selected, the C₅/ \overline{CK} terminal is set as output and clocks are output at the transfer rate selected by bits 0 ~ 3 of the SCI control register.

• TIMER₂

The SCI transfer clock generator can be used as a timer. The clock selected by bits 3 ~ 0 of the SCI control register (4 μ s ~ approx. 32 ms (for oscillation at 4 MHz)) is input to bit 6 of the SCI status register and the TIMER₂ interrupt request bit is set at each falling edge of the clock. Since interrupt requests occur periodically, TIMER₂ can be used as a reload counter or clock.



TIMER₂ is commonly used with the SCI transfer clock generator. If wanting to use TIMER₂ independently of the SCI, specify "External" (SCR5 = 1, SCR4 = 1) as the SCI clock source.

If "Internal" is selected as the clock source, reading or writing the SDR causes the prescaler of the transfer clock generator to be initialized.

■ I/O PORTS

There are 24 input/output terminals (ports A, B, C). Each I/O terminal can be selected for either input or output by the data direction register. More specifically, an I/O port will be input if "0" is written in the data direction register, and output if "1" is written in the data direction register. Port A, B or C reads latched data if it has been programmed as output, even with the output level being fluctuated by the output load. (See Fig. 17.)

When reset, the data direction register and data register go to "0" and all the input/output terminals are used as input.

Bit of data direction register	Bit of output data	Status of output	Input to CPU
1	0	0	0
1	1	1	1
0	X	3-state	Pin

Figure 17 Input/Output Port Diagram

Seven input-only terminals are available (port D). Writing to an input terminal is invalid.

All input/output terminals and input terminals are TTL compatible and CMOS compatible in respect of both input and output.

If I/O ports or input ports are not used, they should be connected to V_{SS} via resistors. With none connected to these terminals, there is the possibility of power being consumed despite that they are not used.

■ RESET

The MPU can be reset either by external reset input (\overline{RES}) or power-on reset. (See Fig. 18.) On power up, the reset input must be held "Low" for at least t_{OSC} to assure that the internal oscillator is stabilized. A sufficient time of delay can be obtained by connecting a capacitance to the \overline{RES} input as shown in Fig. 19.

- ① : Transfer clock generator is reset and mask bit (bit 4 of SCI status register) is cleared.
- ②, ④ : TIMER₂ interrupt request
- ③, ⑤ : TIMER₂ interrupt request bit cleared

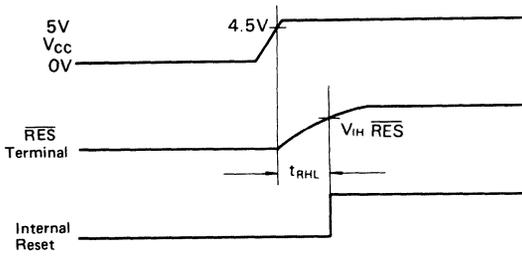


Figure 18 Power On and Reset Timing

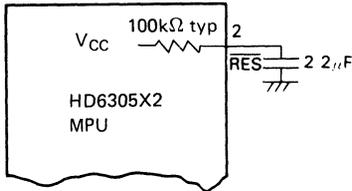


Figure 19 Input Reset Delay Circuit

■ INTERNAL OSCILLATOR

The internal oscillator circuit is designed to meet the

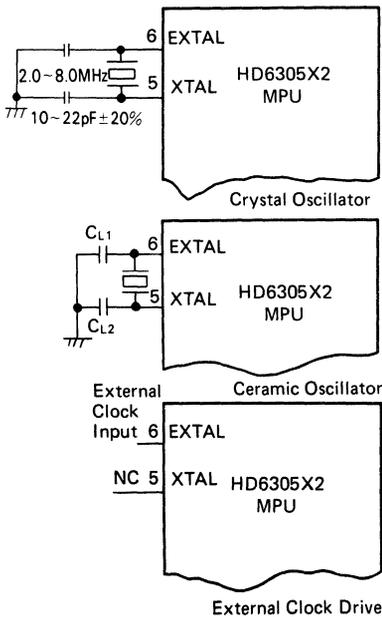


Figure 20 Internal Oscillator Circuit

requirement for minimum external configurations. It can be driven by connecting a crystal (AT cut 2.0 ~ 8.0MHz) or ceramic oscillator between pins 5 and 6 depending on the required oscillation frequency stability.

Three different terminal connections are shown in Fig. 20. Figs. 21 and 22 illustrate the specifications and typical arrangement of the crystal, respectively.

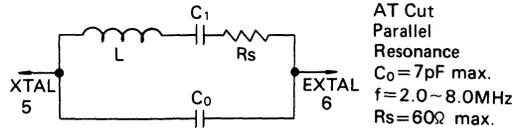
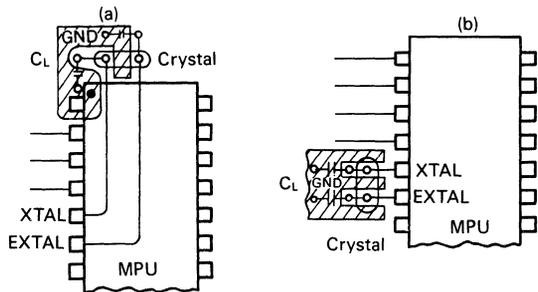


Figure 21 Parameters of Crystal



[NOTE] Use as short wirings as possible for connection of the crystal with the XTAL and XTAL terminals. Do not allow these wirings to cross others.

Figure 22 Typical Crystal Arrangement

■ LOW POWER DISSIPATION MODE

The HD6305X2 has three low power dissipation modes: wait, stop and standby.

• Wait Mode

When WAIT instruction being executed, the MPU enters into the wait mode. In this mode, the oscillator stays active but the internal clock stops. The CPU stops but the peripheral functions – the timer and the serial communication interface – stay active. (NOTE: Once the system has entered the wait mode, the serial communication interface can no longer be retriggered.) In the wait mode, the registers, RAM and I/O terminals hold their condition just before entering into the wait mode.

The escape from this mode can be done by interrupt (INT, TIMER/INT₂ or SCI/TIMER₂), RES or STBY. The RES resets the MPU and the STBY brings it into the standby mode. (This will be mentioned later.)

When interrupt is requested to the CPU and accepted, the wait mode escapes, then the CPU is brought to the operation mode and vectors to the interrupt routine. If the interrupt is masked by the I bit of the condition code register, after releasing from the wait mode the MPU executes the instruction next to the WAIT. If an interrupt other than the INT (i.e., TIMER/INT₂ or SCI/TIMER₂) is masked by the timer control

register, miscellaneous register or serial status register, there is no interrupt request to the CPU, so the wait mode cannot be released.

Fig. 23 shows a flowchart for the wait function.

• Stop Mode

When STOP instruction being executed, MPU enters into the stop mode. In this mode, the oscillator stops and the CPU and peripheral functions become inactive but the RAM, registers and I/O terminals hold their condition just before entering into the stop mode.

The escape from this mode can be done by an external interrupt ($\overline{\text{INT}}$ or $\overline{\text{INT}}_2$), $\overline{\text{RES}}$ or $\overline{\text{STBY}}$. The $\overline{\text{RES}}$ resets the MPU and the $\overline{\text{STBY}}$ brings into the standby mode.

When interrupt is requested to the CPU and accepted, the stop mode escapes, then the CPU is brought to the operation mode and vectors to the interrupt routine. If the interrupt is masked by the I bit of the condition code register, after releasing from the stop mode, the MPU executes the instruction next to the STOP. If the $\overline{\text{INT}}_2$ interrupt is masked by the miscellaneous register, there is no interrupt request to the MPU, so the stop mode cannot be released.

Fig. 24 shows a flowchart for the stop function. Fig. 25 shows a timing chart of return to the operation mode from the stop mode.

For releasing from the stop mode by an interrupt, oscillation starts upon input of the interrupt and, after the internal delay time for stabilized oscillation, the CPU becomes active. For restarting by $\overline{\text{RES}}$, oscillation starts when the $\overline{\text{RES}}$ goes "0" and the CPU restarts when the $\overline{\text{RES}}$ goes "1". The duration of $\text{RES}="0"$ must exceed t_{osc} to assure stabilized oscillation.

• Standby Mode

The MPU enters into the standby mode when the $\overline{\text{STBY}}$ terminal goes "Low". In this mode, all operations stop and the internal condition is reset but the contents of the RAM are hold. The I/O terminals turn to high-impedance state. The standby mode should escape by bringing $\overline{\text{STBY}}$ "High". The CPU must be restarted by reset. The timing of input signals at the $\overline{\text{RES}}$ and $\overline{\text{STBY}}$ terminals is shown in Fig. 26.

Table 4 lists the status of each parts of the MPU in each low power dissipation modes. Transitions between each mode are shown in Fig. 27.

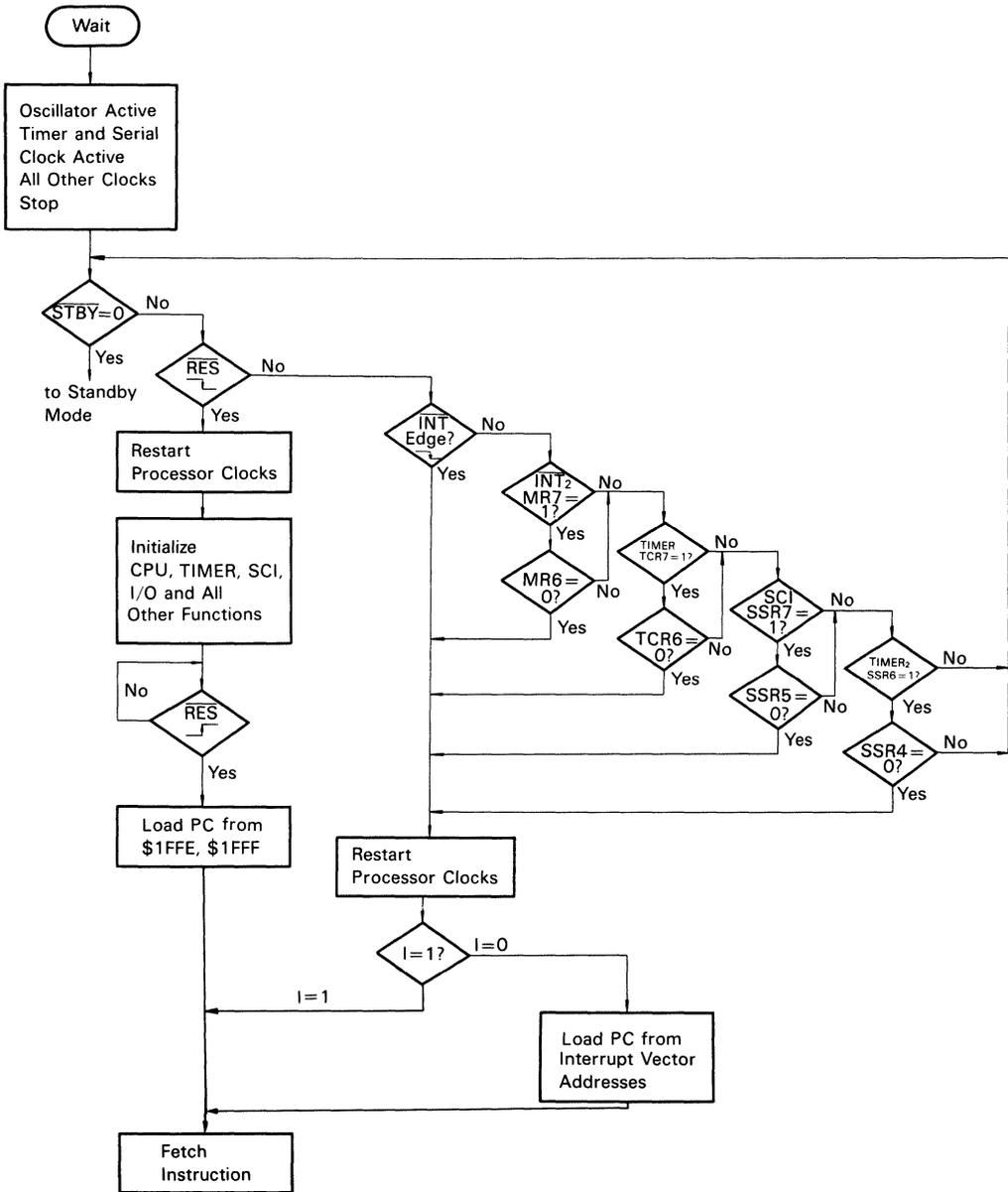


Figure 23 Wait Mode Flow Chart

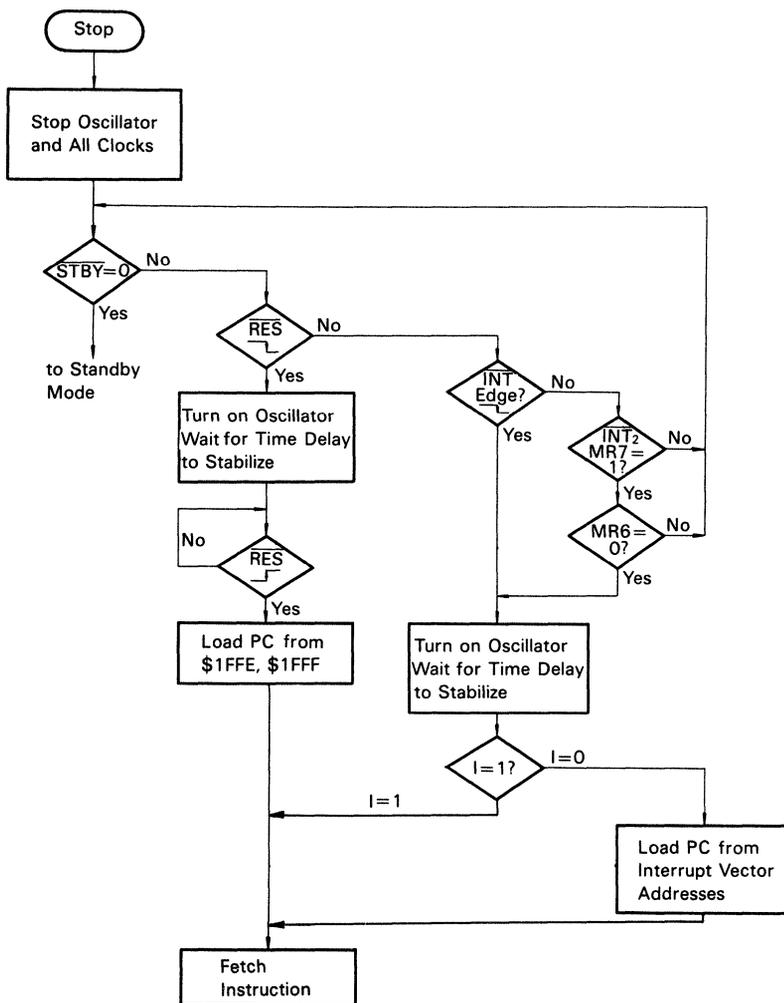


Figure 24 Stop Mode Flow Chart

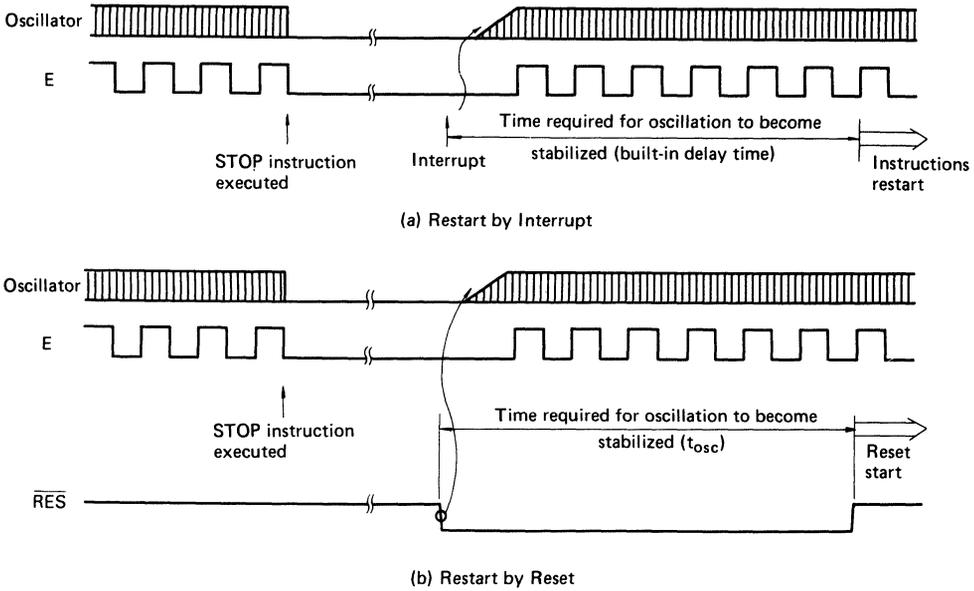


Figure 25 Timing Chart of Releasing from Stop Mode

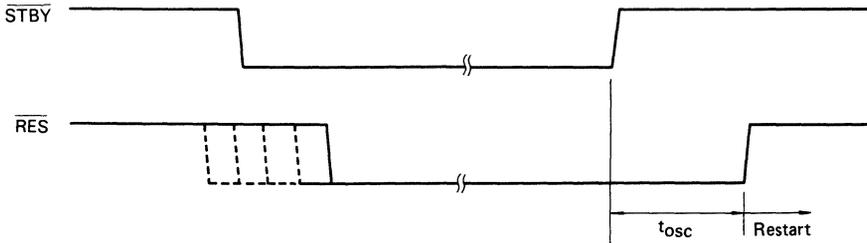


Figure 26 Timing Chart of Releasing from Standby Mode

Table 4 Status of Each Part of MPU in Low Power Dissipation Modes

Mode	Start		Condition						Escape
			Oscillator	CPU	Timer, Serial	Register	RAM	I/O terminal	
WAIT	Soft-ware	WAIT instruction	Active	Stop	Active	Keep	Keep	Keep	\overline{STBY} , RES, INT, INT ₂ , each interrupt request of TIMER, TIMER ₂ , SCI
STOP		STOP instruction	Stop	Stop	Stop	Keep	Keep	Keep	\overline{STBY} , RES, INT, INT ₂
Stand-by	Hard-ware	\overline{STBY} ="Low"	Stop	Stop	Stop	Reset	Keep	High impedance	\overline{STBY} ="High"

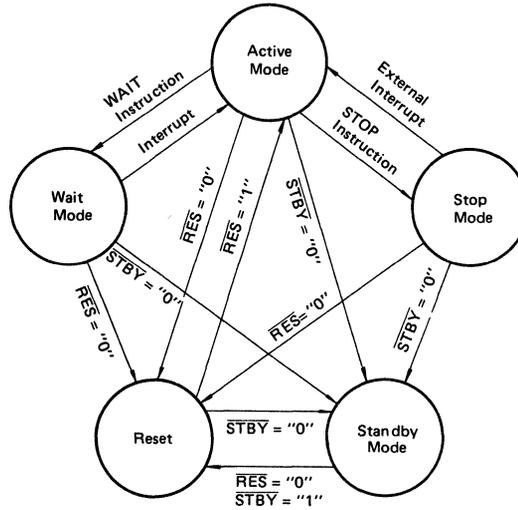


Figure 27 Transitions among Active Mode, Wait Mode, Stop Mode, Standby Mode and Reset

■ BIT MANIPULATION

The MPU can use a single instruction (BSET or BCLR) to set or clear one bit of the RAM or an I/O port (except the write-only registers such as the data direction register). Every bit of memory or I/O within page 0 (\$00 ~ \$FF) can be tested by the BRSET or BRCLR instruction; depending on the result of the test, the program can branch to required destinations. Since bits in the RAM, or I/O can be manipulated, the user may use a bit within the RAM as a flag or handle a single I/O bit as an independent I/O terminal. Fig. 28 shows an example of bit manipulation and the validity of test instructions. In the example, the program is configured assuming that bit 0 of port A is connected to a zero cross detector circuit and bit 1 of the same port to the trigger of a triac.

The program shown can activate the triac within a time of 10μs from zero-crossing through the use of only 7 bytes on the memory. The on-chip timer provides a required time of delay and pulse width modulation of power is also possible.

```

SELF 1.  BRCLR 0, PORT A, SELF 1
          BSET 1, PORT A
          BCLR 1, PORT A
          ⋮

```

Figure 28 Example of Bit Manipulation

■ ADDRESSING MODES

Ten different addressing modes are available to the MPU.

● Immediate

See Fig. 29. The immediate addressing mode provides access to a constant which does not vary during execution of the program.

This access requires an instruction length of 2 bytes. The effective address (EA) is PC and the operand is fetched from

the byte that follows the operation code.

● Direct

See Fig. 30. In the direct addressing mode, the address of the operand is contained in the 2nd byte of the instruction. The user can gain direct access to memory up to the lower 255th address. All RAM and I/O registers are on page 0 of address space so that the direct addressing mode may be utilized.

● Extended

See Fig. 31. The extended addressing is used for referencing to all addresses of memory. The EA is the contents of the 2 bytes that follow the operation code. An extended addressing instruction requires a length of 3 bytes.

● Relative

See Fig. 32. The relative addressing mode is used with branch instructions only. When a branch occurs, the program counter is loaded with the contents of the byte following the operation code. $EA = (PC) + 2 + Rel.$, where Rel. indicates a signed 8-bit data following the operation code. If no branch occurs, Rel. = 0. When a branch occurs, the program jumps to any byte in the range +129 to -127. A branch instruction requires a length of 2 bytes.

● Indexed (No Offset)

See Fig. 33. The indexed addressing mode allows access up to the lower 255th address of memory. In this mode, an instruction requires a length of one byte. The EA is the contents of the index register.

• **Indexed (8-bit Offset)**

See Fig. 34. The EA is the contents of the byte following the operation code, plus the contents of the index register. This mode allows access up to the lower 511th address of memory. Each instruction when used in the index addressing mode (8-bit offset) requires a length of 2 bytes.

• **Indexed (16-bit Offset)**

See Fig. 35. The contents of the 2 bytes following the operation code are added to content of the index register to compute the value of EA. In this mode, the complete memory can be accessed. When used in the indexed addressing mode (16-bit offset), an instruction must be 3 bytes long.

• **Bit Set/Clear**

See Fig. 36. This addressing mode is applied to the BSET and BCLR instructions that can set or clear any bit on page 0. The lower 3 bits of the operation code specify the bit to be set or cleared. The byte that follows the operation code indicates an address within page 0.

• **Bit Test and Branch**

See Fig. 37. This addressing mode is applied to the BRSET and BRCLR instructions that can test any bit within page 0 and can be branched in the relative addressing mode. The byte to be tested is addressed depending on the contents of the byte following the operation code. Individual bits within the byte to be tested are specified by the lower 3 bits of the operation code. The 3rd byte represents a relative value which will be added to the program counter when a branch condition is established. Each of these instructions should be 3 bytes long. The value of the test bit is written in the carry bit of the condition code register.

• **Implied**

See Fig. 38. This mode involves no EA. All information needed for execution of an instruction is contained in the operation code. Direct manipulation on the accumulator and index register is included in the implied addressing mode. Other instructions such as SWI and RTI are also used in this mode. All instructions used in the implied addressing mode should have a length of one byte.

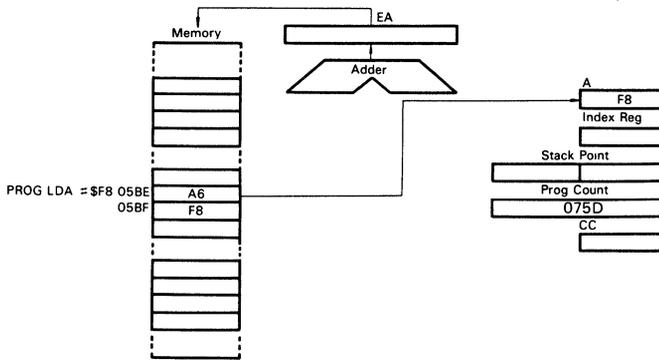


Figure 29 Example of Immediate Addressing

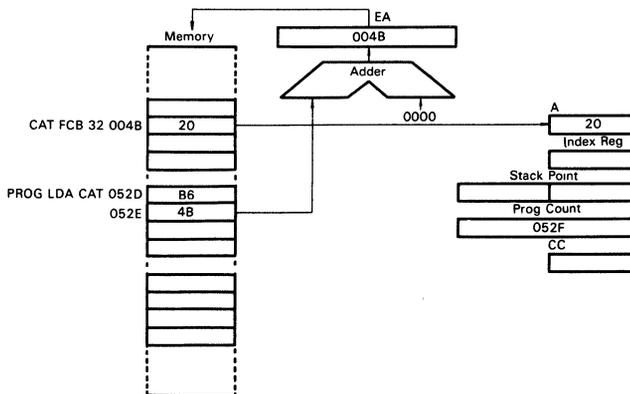


Figure 30 Example of Direct Addressing

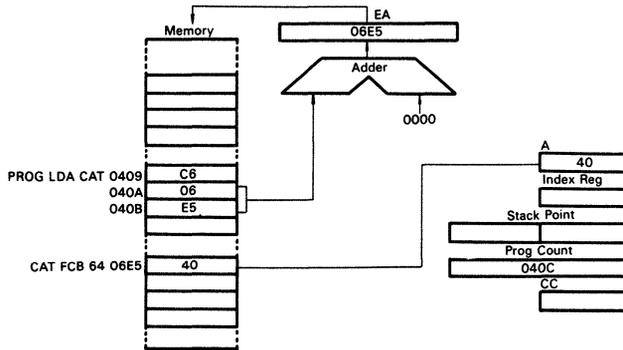


Figure 31 Example of Extended Addressing

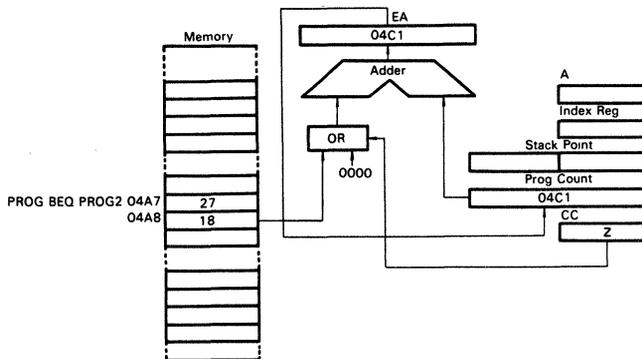


Figure 32 Example of Relative Addressing

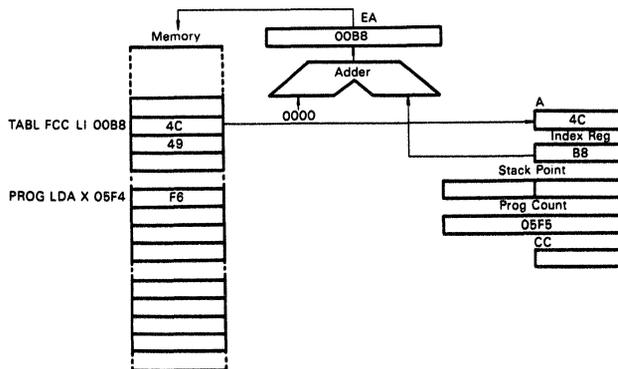


Figure 33 Example of Indexed (No Offset) Addressing

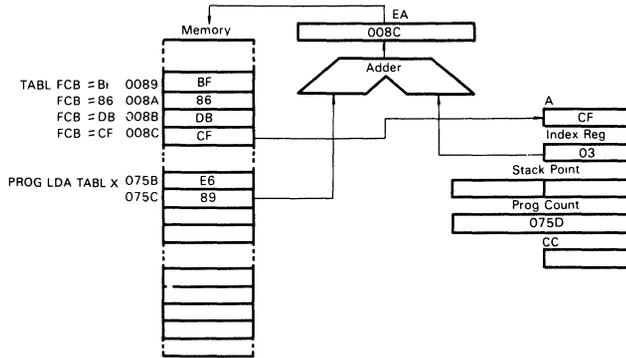


Figure 34 Example of Index (8-bit Offset) Addressing

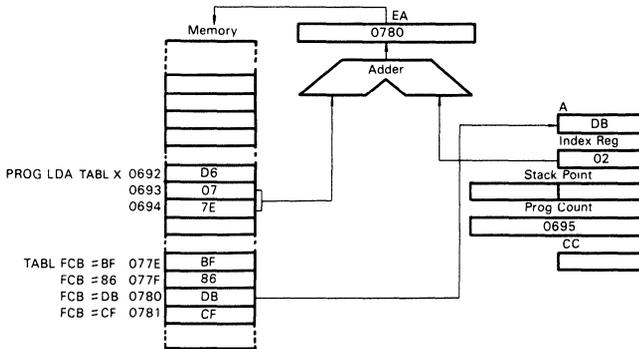


Figure 35 Example of Index (16-bit Offset) Addressing

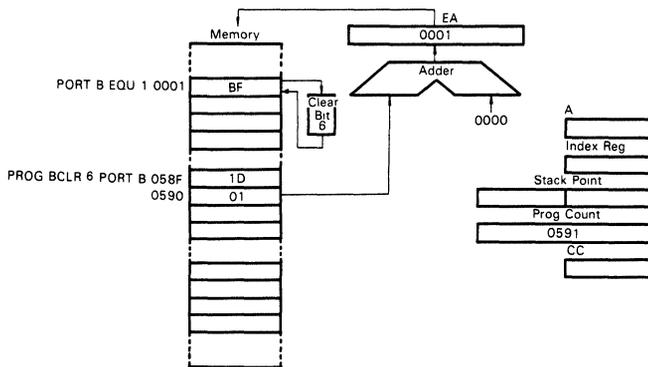


Figure 36 Example of Bit Set/Clear Addressing

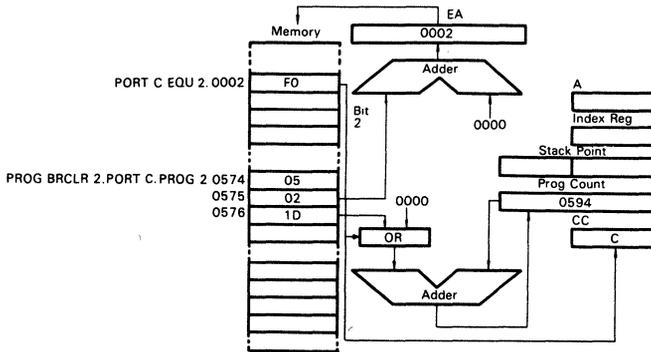


Figure 37 Example of Bit Test and Branch Addressing

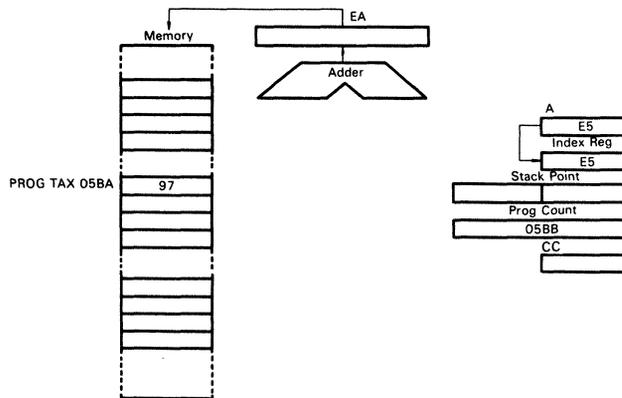


Figure 38 Example of Implied Addressing

■ INSTRUCTION SET

There are 62 basic instructions available to the HD6305X2 MPU. They can be classified into five categories: register/memory, read/modify/write, branch, bit manipulation, and control. The details of each instruction are described in Tables 5 through 11.

● Register/Memory Instructions

Most of these instructions use two operands. One operand is either an accumulator or index register. The other is derived from memory using one of the addressing modes used on the HD6305X2 MPU. There is no register operand in the unconditional jump instruction (JMP) and the subroutine jump instruction (JSR). See Table 5.

● Read/Modify/Write Instructions

These instructions read a memory or register, then modify or test its contents, and write the modified value into the memory or register. Zero test instruction (TST) does not write data, and is handled as an exception in the read/modify/write group. See Table 6.

● Branch Instructions

A branch instruction branches from the program sequence in progress if a particular condition is established. See Table 7.

● Bit Manipulation Instructions

These instructions can be used with any bit located up to the lower 255th address of memory. Two groups are available; one for setting or clearing and the other for bit testing and branching. See Table 8.

● Control Instructions

The control instructions control the operation of the MPU which is executing a program. See Table 9.

● List of Instructions in Alphabetical Order

Table 10 lists all the instructions used on the HD6305X2 MPU in the alphabetical order.

● Operation Code Map

Table 11 shows the operation code map for the instructions used on the MPU.

Table 5 Register/Memory Instructions

Operations	Mnemonic	Addressing Modes												Boolean/ Arithmetic Operation	Condition Code										
		Immediate		Direct		Extended		Indexed (No Offset)		Indexed (8-Bit Offset)		Indexed (16-Bit Offset)			H	I	N	Z	C						
		Op #	~	Op #	~	Op #	~	Op #	~	Op #	~	Op #	~												
Load A from Memory	LDA	A6	2	2	B6	2	3	C6	3	4	F6	1	3	E6	2	4	D6	3	5	M→A	●	●	▲	▲	●
Load X from Memory	LDX	AE	2	2	BE	2	3	CE	3	4	FE	1	3	EE	2	4	DE	3	5	M→X	●	●	▲	▲	●
Store A in Memory	STA	—	—	—	B7	2	3	C7	3	4	F7	1	4	E7	2	4	D7	3	5	A→M	●	●	▲	▲	●
Store X in Memory	STX	—	—	—	BF	2	3	CF	3	4	FF	1	4	EF	2	4	DF	3	5	X→M	●	●	▲	▲	●
Add Memory to A	ADD	AB	2	2	BB	2	3	CB	3	4	FB	1	3	EB	2	4	DB	3	5	A+M→A	▲	▲	▲	▲	▲
Add Memory and Carry to A	ADC	A9	2	2	B9	2	3	C9	3	4	F9	1	3	E9	2	4	D9	3	5	A+M+C→A	▲	▲	▲	▲	▲
Subtract Memory	SUB	A0	2	2	B0	2	3	C0	3	4	F0	1	3	E0	2	4	D0	3	5	A-M→A	●	●	▲	▲	▲
Subtract Memory from A with Borrow	SBC	A2	2	2	B2	2	3	C2	3	4	F2	1	3	E2	2	4	D2	3	5	A-M-C→A	●	●	▲	▲	▲
AND Memory to A	AND	A4	2	2	B4	2	3	C4	3	4	F4	1	3	E4	2	4	D4	3	5	A·M→A	●	●	▲	▲	●
OR Memory with A	ORA	AA	2	2	BA	2	3	CA	3	4	FA	1	3	EA	2	4	DA	3	5	A+M→A	●	●	▲	▲	●
Exclusive OR Memory with A	EOR	A8	2	2	B8	2	3	C8	3	4	F8	1	3	E8	2	4	D8	3	5	A+M→A	●	●	▲	▲	●
Arithmetic Compare A with Memory	CMP	A1	2	2	B1	2	3	C1	3	4	F1	1	3	E1	2	4	D1	3	5	A-M	●	●	▲	▲	▲
Arithmetic Compare X with Memory	CPX	A3	2	2	B3	2	3	C3	3	4	F3	1	3	E3	2	4	D3	3	5	X-M	●	●	▲	▲	▲
Bit Test Memory with A (Logical Compare)	BIT	A5	2	2	B5	2	3	C5	3	4	F5	1	3	E5	2	4	D5	3	5	A·M	●	●	▲	▲	●
Jump Unconditional	JMP				BC	2	2	CC	3	3	FC	1	2	EC	2	3	DC	3	4		●	●	●	●	●
Jump to Subroutine	JSR				BD	2	5	CD	3	6	FD	1	5	ED	2	5	DD	3	6		●	●	●	●	●

Symbols: Op = Operation
= Number of bytes
~ = Number of cycles

Table 6 Read/Modify/Write Instructions

Operations	Mnemonic	Addressing Modes										Boolean/Arithmetic Operation	Condition Code									
		Implied(A)		Implied(X)		Direct		Indexed (No Offset)		Indexed (8-Bit Offset)			H	I	N	Z	C					
		Op #	~	Op #	~	Op #	~	Op #	~	Op #	~											
Increment	INC	4C	1	2	5C	1	2	3C	2	5	7C	1	5	6C	2	6	A+1→A or X+1→X or M+1→M	●	●	▲	▲	●
Decrement	DEC	4A	1	2	5A	1	2	3A	2	5	7A	1	5	6A	2	6	A-1→A or X-1→X or M-1→M	●	●	▲	▲	●
Clear	CLR	4F	1	2	5F	1	2	3F	2	5	7F	1	5	6F	2	6	00→A or 00→X or 00→M	●	●	0	1	●
Complement	COM	43	1	2	53	1	2	33	2	5	73	1	5	63	2	6	\bar{A} →A or \bar{X} →X or \bar{M} →M	●	●	▲	▲	1
Negate (2's Complement)	NEG	40	1	2	50	1	2	30	2	5	70	1	5	60	2	6	00→A→A or 00→X→X or 00→M→M	●	●	▲	▲	▲
Rotate Left Thru Carry	ROL	49	1	2	59	1	2	39	2	5	79	1	5	69	2	6		●	●	▲	▲	▲
Rotate Right Thru Carry	ROR	46	1	2	56	1	2	36	2	5	76	1	5	66	2	6		●	●	▲	▲	▲
Logical Shift Left	LSL	48	1	2	58	1	2	38	2	5	78	1	5	68	2	6		●	●	▲	▲	▲
Logical Shift Right	LSR	44	1	2	54	1	2	34	2	5	74	1	5	64	2	6		●	●	0	▲	▲
Arithmetic Shift Right	ASR	47	1	2	57	1	2	37	2	5	77	1	5	67	2	6		●	●	▲	▲	▲
Arithmetic Shift Left	ASL	48	1	2	58	1	2	38	2	5	78	1	5	68	2	6	Equal to LSL	●	●	▲	▲	▲
Test for Negative or Zero	TST	4D	1	2	5D	1	2	3D	2	4	7D	1	4	6D	2	5	A-00 or X-00 or M-00	●	●	▲	▲	●

Symbols: Op = Operation
= Number of bytes
~ = Number of cycles

Table 7 Branch Instructions

Operations	Mnemonic	Addressing Modes			Branch Test	Condition Code				
		Relative				H	I	N	Z	C
		OP	#	~						
Branch Always	BRA	20	2	3	None	●	●	●	●	●
Branch Never	BRN	21	2	3	None	●	●	●	●	●
Branch IF Higher	BHI	22	2	3	C+Z=0	●	●	●	●	●
Branch IF Lower or Same	BLS	23	2	3	C+Z=1	●	●	●	●	●
Branch IF Carry Clear	BCC	24	2	3	C=0	●	●	●	●	●
(Branch IF Higher or Same)	(BHS)	24	2	3	C=0	●	●	●	●	●
Branch IF Carry Set	BCS	25	2	3	C=1	●	●	●	●	●
(Branch IF Lower)	(BLO)	25	2	3	C=1	●	●	●	●	●
Branch IF Not Equal	BNE	26	2	3	Z=0	●	●	●	●	●
Branch IF Equal	BEQ	27	2	3	Z=1	●	●	●	●	●
Branch IF Half Carry Clear	BHCC	28	2	3	H=0	●	●	●	●	●
Branch IF Half Carry Set	BHCS	29	2	3	H=1	●	●	●	●	●
Branch IF Plus	BPL	2A	2	3	N=0	●	●	●	●	●
Branch IF Minus	BMI	2B	2	3	N=1	●	●	●	●	●
Branch IF Interrupt Mask Bit is Clear	BMC	2C	2	3	I=0	●	●	●	●	●
Branch IF Interrupt Mask Bit is Set	BMS	2D	2	3	I=1	●	●	●	●	●
Branch IF Interrupt Line is Low	BIL	2E	2	3	INT=0	●	●	●	●	●
Branch IF Interrupt Line is High	BIH	2F	2	3	INT=1	●	●	●	●	●
Branch to Subroutine	BSR	AD	2	5	—	●	●	●	●	●

Symbols: Op = Operation
 # = Number of bytes
 ~ = Number of cycles

Table 8 Bit Manipulation Instructions

Operations	Mnemonic	Addressing Modes						Boolean/Arithmetic Operation	Branch Test	Condition Code				
		Bit Set / Clear			Bit Test and Branch					H	I	N	Z	C
		OP	#	~	OP	#	~							
Branch IF Bit n is set	BRSET n(n=0...7)	—	—	—	2·n	3	5	—	Mn=1	●	●	●	●	^
Branch IF Bit n is clear	BRCLR n(n=0...7)	—	—	—	01+2·n	3	5	—	Mn=0	●	●	●	●	^
Set Bit n	BSET n(n=0...7)	10+2·n	2	5	—	—	—	1→Mn	—	●	●	●	●	●
Clear Bit n	BCLR n(n=0...7)	11+2·n	2	5	—	—	—	0→Mn	—	●	●	●	●	●

Symbols: Op = Operation
 # = Number of bytes
 ~ = Number of cycles

Table 9 Control Instructions

Operations	Mnemonic	Addressing Modes			Boolean Operation	Condition Code				
		Implied				H	I	N	Z	C
		OP	#	~						
Transfer A to X	TAX	97	1	2	A→X	●	●	●	●	●
Transfer X to A	TXA	9F	1	2	X→A	●	●	●	●	●
Set Carry Bit	SEC	99	1	1	1→C	●	●	●	●	1
Clear Carry Bit	CLC	98	1	1	0→C	●	●	●	●	0
Set Interrupt Mask Bit	SEI	9B	1	2	1→I	●	1	●	●	●
Clear Interrupt Mask Bit	CLI	9A	1	2	0→I	●	0	●	●	●
Software Interrupt	SWI	83	1	10		●	1	●	●	●
Return from Subroutine	RTS	81	1	5		●	●	●	●	●
Return from Interrupt	RTI	80	1	8		?	?	?	?	?
Reset Stack Pointer	RSP	9C	1	2	\$\$FF→SP	●	●	●	●	●
No-Operation	NOP	9D	1	1	Advance Prog. Cntr. Only	●	●	●	●	●
Decimal Adjust A	DAA	8D	1	2	Converts binary add of BCD charcters into BCD format	●	●	^	^	^*
Stop	STOP	8E	1	4		●	●	●	●	●
Wait	WAIT	8F	1	4		●	●	●	●	●

Symbols: Op = Operation
 # = Number of bytes
 ~ = Number of cycles
 * Are BCD characters of upper byte 10 or more? (They are not cleared if set in advance.)

Table 10 Instruction Set (in Alphabetical Order)

Mnemonic	Addressing Modes										Condition Code				
	Implied	Immediate	Direct	Extended	Relative	Indexed (No Offset)	Indexed (8-Bit)	Indexed (16-Bit)	Bit Set/Clear	Bit Test & Branch	H	I	N	Z	C
ADC		x	x	x		x	x	x			^	●	^	^	^
ADD		x	x	x		x	x	x			^	●	^	^	^
AND		x	x	x		x	x	x			●	●	^	^	^
ASL	x		x			x	x				●	●	^	^	^
ASR	x		x			x	x				●	●	^	^	^
BCC					x						●	●	●	●	●
BCLR									x		●	●	●	●	●
BCS					x						●	●	●	●	●
BEQ					x						●	●	●	●	●
BHCC					x						●	●	●	●	●
BHCS					x						●	●	●	●	●
BHI					x						●	●	●	●	●
(BHS)					x						●	●	●	●	●
BIH					x						●	●	●	●	●
BIL					x						●	●	●	●	●
BIT		x	x	x		x	x	x			●	●	^	^	^
(BLO)					x						●	●	●	●	●
BLS					x						●	●	●	●	●
BMC					x						●	●	●	●	●
BMI					x						●	●	●	●	●
BMS					x						●	●	●	●	●
BNE					x						●	●	●	●	●
BPL					x						●	●	●	●	●
BRA					x						●	●	●	●	●

Condition Code Symbols:
 H Half Carry (From Bit 3)
 I Interrupt Mask
 N Negative (Sign Bit)
 Z Zero
 C Carry/Borrow
 ^ Test and Set if True, Cleared Otherwise
 ● Not Affected
 ? Load CC Register From Stack

(to be continued)

Table 10 Instruction Set (in Alphabetical Order)

Mnemonic	Addressing Modes										Condition Code				
	Implied	Immediate	Direct	Extended	Relative	Indexed (No Offset)	Indexed (8-Bit)	Indexed (16-Bit)	Bit Set/ Clear	Bit Test & Branch	H	I	N	Z	C
BRN					X						●	●	●	●	●
BRCLR										X	●	●	●	●	^
BRSET										X	●	●	●	●	^
BSET									X		●	●	●	●	●
BSR					X						●	●	●	●	●
CLC	X										●	●	●	●	0
CLI	X										●	0	●	●	●
CLR	X		X			X	X				●	●	0	1	●
CMP		X	X	X		X	X	X			●	●	^	^	^
COM	X		X			X	X				●	●	^	^	1
CPX		X	X	X		X	X	X			●	●	^	^	^
DAA	X										●	●	^	^	^
DEC	X		X			X	X				●	●	^	^	●
EOR		X	X	X		X	X	X			●	●	^	^	●
INC	X		X			X	X				●	●	^	^	●
JMP			X	X		X	X	X			●	●	●	●	●
JSR			X	X		X	X	X			●	●	●	●	●
LDA		X	X	X		X	X	X			●	●	^	^	●
LDX		X	X	X		X	X	X			●	●	^	^	●
LSL	X		X			X	X				●	●	^	^	^
LSR	X		X			X	X				●	●	0	^	^
NEG	X		X			X	X				●	●	^	^	^
NOP	X										●	●	●	●	●
ORA		X	X	X		X	X	X			●	●	^	^	●
ROL	X		X			X	X				●	●	^	^	^
ROR	X		X			X	X				●	●	^	^	^
RSP	X										●	●	●	●	●
RTI	X										?	?	?	?	?
RTS	X										●	●	●	●	●
SBC		X	X	X		X	X	X			●	●	^	^	^
SEC	X										●	●	●	●	1
SEI	X										●	1	●	●	●
STA			X	X		X	X	X			●	●	^	^	●
STOP	X										●	●	●	●	●
STX			X	X		X	X	X			●	●	^	^	●
SUB		X	X	X		X	X	X			●	●	^	^	^
SWI	X										●	1	●	●	●
TAX	X										●	●	●	●	●
TST	X		X			X	X				●	●	^	^	●
TXA	X										●	●	●	●	●
WAIT	X										●	●	●	●	●

Condition Code Symbols:

- H Half Carry (From Bit 3)
- I Interrupt Mask
- N Negative (Sign Bit)
- Z Zero
- C Carry/Borrow
- ^ Test and Set if True, Cleared Otherwise
- Not Affected
- ? Load CC Register From Stack

Table 11 Operation Code Map

Bit Manipulation		Branch	Read/Modify/Write					Control		Register/Memory								
Test & Branch	Set/Clear	Rel	DIR	A	X	.X1	.X0	IMP	IMP	IMM	DIR	EXT	.X2	.X1	.X0			
0	1	2	3	4	5	6	7	8	9	A	B	C	D	E	F	← HIGH		
0	BRSET0	BSET0	BRA	NEG					RTI*	—	SUB						0	
1	BRCLR0	BCLR0	BRN	—					RTS*	—	CMP						1	
2	BRSET1	BSET1	BHI	—					—	—	SBC						2	
3	BRCLR1	BCLR1	BLS	COM					SWI*	—	CPX						3	
4	BRSET2	BSET2	BCC	LSR					—	—	AND						4	
5	BRCLR2	BCLR2	BCS	—					—	—	BIT						5	
6	BRSET3	BSET3	BNE	ROR					—	—	LDA						6	
7	BRCLR3	BCLR3	BEQ	ASR					—	TAX*	—	STA				STA(+1)	7	
8	BRSET4	BSET4	BHCC	LSL/ASL					—	CLC	EOR						8	
9	BRCLR4	BCLR4	BHCS	ROL					—	SEC	ADC						9	
A	BRSET5	BSET5	BPL	DEC					—	CLI*	ORA						A	
B	BRCLR5	BCLR5	BMI	—					—	SEI*	ADD						B	
C	BRSET6	BSET6	BMC	INC					—	RSP*	—	JMP(-1)						C
D	BRCLR6	BCLR6	BMS	TST(-1)	TST	TST(-1)	DAA*	NOP	BSR*	JSR(+2)	JSR(+1)	JSR(+2)				D		
E	BRSET7	BSET7	BIL	—					STOP*	—	LDX						E	
F	BRCLR7	BCLR7	BIH	CLR					WAIT*	TXA*	—	STX				STX(+1)	F	
	3/5	2/5	2/3	2/5	1/2	1/2	2/6	1/5	1/*	1/1	2/2	2/3	3/4	3/5	2/4	1/3		

- (NOTES)
1. "—" is an undefined operation code.
 2. The lowermost numbers in each column represent a byte count and the number of cycles required (byte count/number of cycles). The number of cycles for the mnemonics asterisked (*) is as follows:

RTI	8	TAX	2
RTS	5	RSP	2
SWI	10	TXA	2
DAA	2	BSR	5
STOP	4	CLI	2
WAIT	4	SEI	2
 3. The parenthesized numbers must be added to the cycle count of the particular instruction.

● **Additional Instructions**

- The following new instructions are used on the HD6305X2:
- DAA** Converts the contents of the accumulator into BCD code.
 - WAIT** Causes the MPU to enter the wait mode. For this mode, see the topic, Wait Mode.
 - STOP** Causes the MPU to enter the stop mode. For this mode, see the topic, Stop Mode.

■ **OPERATION AT EACH INSTRUCTION CYCLE**

The HD6305X2 employs a mechanism of the pipeline control for the instruction fetch and the subsequent instruction fetch is performed during the current instruction being executed.

Table 12 provides the information about the relationship among each data on the Address Bus, Data Bus and R/W status in cycle-by-cycle basis during the execution of each instruction.

Table 12 Cycle-by-Cycle Operation

Address Mode & Instructions	Cycles	Cycle #	Address Bus	R/W	Data Bus
IMMEDIATE					
ADC, ADD, AND, BIT, CMP, CPX, EOR, LDA, LDX, ORA, SBC, SUB	2	1	Op Code Address +1	1	Operand Data
		2	Op Code Address +2	1	Next Op Code
DIRECT					
ADC, ADD, AND, BIT, CMP, CPX, EOR, LDA, LDX, ORA, SBC, SUB	3	1	Op Code Address +1	1	Address of Operand
		2	Address of Operand	1	Operand Data
		3	Op Code Address +2	1	Next Op Code

(to be continued)

Address Mode & Instructions	Cycles	Cycle #	Address Bus	R/W	Data Bus
STA, STX	3	1	Op Code Address +1	1	Address of Operand
		2	Address of Operand	0	(Data from Acc. Data from Ix.
		3	Op Code Address +1	1	Next Op Code
JMP	2	1	Op Code Address +1	1	Jump Address
		2	Jump Address	1	Next Op Code
JSR	5	1	Op Code Address +1	1	Jump Address (LSB)
		2	1FFF	1	Irrelevant Data
		3	Stack Pointer	0	Return Address (LSB)
		4	Stack Pointer -1	0	Return Address (MSB)
		5	Jump Address	1	First Subroutine Op Code
ASR, CLR, COM, DEC, INC, LSL, LSR, NEG, ROL, ROR	5	1	Op Code Address +1	1	Address of Operand
		2	Address of Operand	1	Operand Data
		3	1FFF	1	Irrelevant Data
		4	Address of Operand	0	New Operand Data
		5	Op Code Address +2	1	Next Op Code
TST	4	1	Op Code Address +1	1	Address of Operand
		2	Address of Operand	1	Operand Data
		3	1FFF	1	Irrelevant Data
		4	Op Code Address +2	1	Next Op Code
EXTENDED					
ADC, ADD, AND, BIT, CMP, CPX, EOR, LDA, LDX, ORA, SBC, SUB	4	1	Op Code Address +1	1	Address of Operand (MSB)
		2	Op Code Address +2	1	Address of Operand (LSB)
		3	Address of Operand	1	Operand Data
		4	Op Code Address +3	1	Next Op Code
STA, STX	4	1	Op Code Address +1	1	Address of Operand (MSB)
		2	Op Code Address +2	1	Address of Operand (LSB)
		3	Address of Operand	0	(Data from Acc. Data from Ix.
		4	Op Code Address +3	1	Next Op Code
JMP	3	1	Op Code Address +1	1	Jump Address (MSB)
		2	Op Code Address +2	1	Jump Address (LSB)
		3	Jump Address	1	Next Op Code
JSR	6	1	Op Code Address +1	1	Jump Address (MSB)
		2	Op Code Address +2	1	Jump Address (LSB)
		3	1FFF	1	Irrelevant Data
		4	Stack Pointer	0	Return Address (LSB)
		5	Stack Pointer -1	0	Return Address (MSB)
		6	Jump Address	1	First Subroutine Op Code
INDEXED (No offset)					
ADC, ADD, AND, BIT, CMP, CPX, EOR, LDA, LDX, ORA, SBC, SUB	3	1	Op Code Address +1	1	Next Op Code
		2	Ix	1	Operand Data
		3	Op Code Address +1	1	Next Op Code
STA, STX	4	1	Op Code Address +1	1	Next Op Code
		2	1FFF	1	Irrelevant Data
		3	Ix	0	(Data from Acc. Data from Ix.
		4	Op Code Address +1	1	Next Op Code
JMP	2	1	Op Code Address +1	1	Next Op Code
		2	Ix	1	First Op Code of Jump Routine

(to be continued)

Address Mode & Instructions	Cycles	Cycle #	Address Bus	R/W	Data Bus
JSR	5	1	Op Code Address +1	1	Next Op Code
		2	1FFF	1	Irrelevant Data
		3	Stack Pointer	0	Return Address (LSB)
		4	Stack Pointer -1	0	Return Address (MSB)
		5	Ix	1	First Subroutine Op Code
ASR, CLR, COM, DEC, INC, LSL, LSR, NEG, ROL, ROR	5	1	Op Code Address +1	1	Next Op Code
		2	Ix	1	Operand Data
		3	1FFF	1	Irrelevant Data
		4	Ix	0	New Operand Data
		5	Op Code Address +1	1	Next Op Code
TST	4	1	Op Code Address +1	1	Next Op Code
		2	Ix	1	Operand Data
		3	1FFF	1	Irrelevant Data
		4	Op Code Address +1	1	Next Op Code
INDEXED (8-bit offset)					
ADC, ADD, AND, BIT, CMP, CPX, EOR, LDA, LDX, ORA, SBC, SUB	4	1	Op Code Address +1	1	Offset
		2	1FFF	1	Irrelevant Data
		3	Ix + Offset	1	Operand Data
		4	Op Code Address +2	1	Next Op Code
STA, STX	4	1	Op Code Address +1	1	Offset
		2	1FFF	1	Irrelevant Data
		3	Ix + Offset	0	(Data from Acc. Data from Ix.
		4	Op Code Address +2	1	Next Op Code
JMP	3	1	Op Code Address +1	1	Offset
		2	1FFF	1	Irrelevant Data
		3	Ix + Offset	1	First Op Code of Jump Routine
JSR	5	1	Op Code Address +1	1	Offset
		2	1FFF	1	Irrelevant Data
		3	Stack Pointer	0	Return Address (LSB)
		4	Stack Pointer -1	0	Return Address (MSB)
		5	Ix + Offset	1	First Subroutine Op Code
ASR, CLR, COM, DEC, INC, LSL, LSR, NEG, ROL, ROR	6	1	Op Code Address +1	1	Offset
		2	1FFF	1	Irrelevant Data
		3	Ix + Offset	1	Operand Data
		4	1FFF	1	Irrelevant Data
		5	Ix + Offset	0	New Operand Data
		6	Op Code Address +1	1	Next Op Code
TST	5	1	Op Code Address +1	1	Offset
		2	1FFF	1	Irrelevant Data
		3	Ix + Offset	1	Operand Data
		4	1FFF	1	Irrelevant Data
		5	Op Code Address +2	1	Next Op Code
INDEXED (16-bit offset)					
ADC, ADD, AND, BIT, CMP, CPX, EOR, LDA, LDX, ORA, SBC, SUB	5	1	Op Code Address +1	1	Offset (MSB)
		2	Op Code Address +2	1	Offset (LSB)
		3	1FFF	1	Irrelevant Data
		4	Ix + Offset	1	Operand Data
		5	Op Code Address +1	1	Next Op Code

(to be continued)

Address Mode & Instructions	Cycles	Cycle #	Address Bus	R/W	Data Bus
STA, STX	5	1	Op Code Address +1	1	Offset (MSB)
		2	Op Code Address +2	1	Offset (LSB)
		3	1FFF	1	Irrelevant Data
		4	Ix + Offset	0	(Data from Acc. Data from Ix.
		5	Op Code Address +3	1	Next Op Code
JMP	4	1	Op Code Address +1	1	Offset (MSB)
		2	Op Code Address +2	1	Offset (LSB)
		3	1FFF	1	Irrelevant Data
		4	Ix + Offset	1	First Op Code of Jump Routine
JSR	6	1	Op Code Address +1	1	Offset (MSB)
		2	Op Code Address +2	1	Offset (LSB)
		3	1FFF	1	Irrelevant Data
		4	Stack Pointer	0	Return Address (LSB)
		5	Stack Pointer -1	0	Return Address (MSB)
		6	Ix + Offset	1	First Subroutine Op Code
IMPLIED					
ASR, CLR, COM, DEC, INC, LSL, LSR, NEG, ROL, ROR, TST	2	1	Op Code Address +1	1	Next Op Code
		2	Op Code Address +1	1	Next Op Code
CLC, NOP, SEC	1	1	Op Code Address +1	1	Next Op Code
RSP, TAX, TXA	2	1	Op Code Address +1	1	Next Op Code
		2	Op Code Address +1	1	Next Op Code
CLI, SEI	2	1	Op Code Address +1	1	Next Op Code
		2	1FFF	1	Irrelevant Data
DAA	2	1	Op Code Address +1	1	Next Op Code
		2	Op Code Address +1	1	Next Op Code
STOP, WAIT	4	1	Op Code Address +1	1	Next Op Code
		2	1FFF	1	Irrelevant Data
		3	1FFF	1	Irrelevant Data
		4	Op Code Address +1	1	Next Op Code
RTI	8	1	Op Code Address +1	1	Next Op Code
		2	1FFF	1	Irrelevant Data
		3	Stack Pointer	1	CC
		4	Stack Pointer +1	1	Acc.
		5	Stack Pointer +2	1	Ix.
		6	Stack Pointer +3	1	Return Address (MSB)
		7	Stack Pointer +4	1	Return Address (LSB)
		8	Return Address	1	First Op Code of Return Routine
HTS	5	1	Op Code Address +1	1	Next Op Code
		2	1FFF	1	Irrelevant Data
		3	Stack Pointer	1	Return Address (MSB)
		4	Stack Pointer +1	1	Return Address (LSB)
		5	Return Address	1	First Op Code of Return Routine
SWI	10	1	Op Code Address +1	1	Next Op Code
		2	1FFF	1	Irrelevant Data
		3	Stack Pointer	0	Return Address (LSB)
		4	Stack Pointer-1	0	Return Address (MSB)
		5	Stack Pointer-2	0	Ix.
		6	Stack Pointer-3	0	Acc.
		7	Stack Pointer-4	0	CC
		8	Vector Address 1FFC	1	Address of SWI Routine (MSB)
		9	Vector Address 1FFD	1	Address of SWI Routine (LSB)
		10	Address of SWI Routine	1	First Op Code of SWI Routine

Address Mode & Instructions	Cycles	Cycle #	Address Bus	R/W	Data Bus
RELATIVE					
BCC, BCS, BEQ, BHCC, BHCS, BHI, BIH, BIL, BLS, BMC, BMI, BMS, BNE, BPL, BRA, BRN	3	1	Op Code Address +1	1	Next Op Code
		2	1FFF	1	Irrelevant Data
		3	(Branch AddressTest = "1" Op Code Address +1 Test = "0"	1	(First Op Code of Branch Routine Next Op Code
BSR	5	1	Op Code Address +1	1	Offset
		2	1FFF	1	Irrelevant Data
		3	Stack Pointer	0	Return Address (LSB)
		4	Stack Pointer-1	0	Return Address (MSB)
		5	Branch Address	1	First Op Code of Subroutine
BIT TEST AND BRANCH					
BRCLR, BRSET	5	1	Op Code Address +1	1	Address of Operand
		2	Address of Operand	1	Operand Data
		3	Op Code Address +2	1	Offset
		4	1FFF	1	Irrelevant Data
		5	(Branch AddressTest = "1" Op Code Address +3 Test = "0"	1	(First Op Code of Branch Address Next Op Code
BIT SET/CLEAR					
BCLR, BSET	5	1	Op Code Address +1	1	Address of Operand
		2	Address of Operand	1	Operand Data
		3	1FFF	1	Irrelevant Data
		4	Address of Operand	0	New Operand Data
		5	Op Code Address +1	1	Next Op Code

HD6305Y2, HD63A05Y2, HD63B05Y2 CMOS MPU (Micro Processing Unit)

—PRELIMINARY—

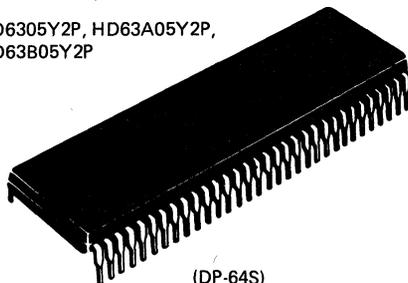
The HD6305Y2 is a CMOS 8-bit micro processing unit. A CPU, a clock generator, a 256 byte RAM, I/O terminals, two timers and a serial communication interface (SCI) are built in the HD6305Y2.

The HD6305Y2 has the same functions as the HD6305Y0's except for the number of I/O terminals. Its memory space is expandable to 16k bytes externally

■ HARDWARE FEATURES

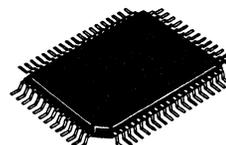
- 8-bit based MPU
- 256 bytes of RAM
- A total of 31 terminals, including 24 I/O's, 7 inputs
- Two timers
 - 8-bit timer with a 7-bit prescaler (programmable prescaler; event counter)
 - 15-bit timer (commonly used with the SCI clock divider)
- On-chip serial interface circuit (synchronized with clock)
- Six interrupts (two external, two timer, one serial and one software)
- Low power dissipation modes
 - Wait In this mode, the clock oscillator is on and the CPU halts but the timer/serial/interrupt function is operatable.
 - Stop In this mode, the clock stops but the RAM data, I/O status and registers are held.
 - Standby . . In this mode, the clock stops, the RAM data is held, and the other internal condition is reset.
- Minimum instruction cycle time
 - HD6305Y2 1 μ s ($f = 1$ MHz)
 - HD63A05Y2 0.67 μ s ($f = 1.5$ MHz)
 - HD63B05Y2 0.5 μ s ($f = 2$ MHz)
- Wide operating range
 - $V_{CC} = 3$ to 6V ($f = 0.1$ to 0.5 MHz)
 - HD6305Y2 $f = 0.1$ to 1 MHz ($V_{CC} = 5V \pm 10\%$)
 - HD63A05Y2 $f = 0.1$ to 1.5 MHz ($V_{CC} = 5V \pm 10\%$)
 - HD63B05Y2 $f = 0.1$ to 2 MHz ($V_{CC} = 5V \pm 10\%$)
- System development fully supported by an evaluation kit

HD6305Y2P, HD63A05Y2P,
HD63B05Y2P



(DP-64S)

HD6305Y2F, HD63A05Y2F,
HD63B05Y2F



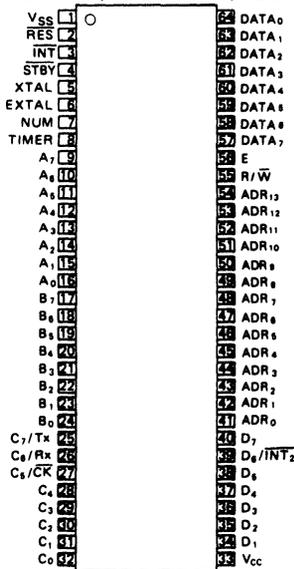
(FP-64)

■ SOFTWARE FEATURES

- Similar to HD6800
- Byte efficient instruction set
- Powerful bit manipulation instructions (Bit Set, Bit Clear, and Bit Test and Branch usable for 192 byte RAM bits within page 0 and all I/O terminals)
- A variety of interrupt operations
- Index addressing mode useful for table processing
- A variety of conditional branch instructions
- Ten powerful addressing modes
- All addressing modes adaptable to RAM, and I/O instructions
- Three new instructions, STOP, WAIT and DAA, added to the HD6805 family instruction set
- Instructions that are upward compatible with those of Motorola's MC6805P2 and MC146805G2

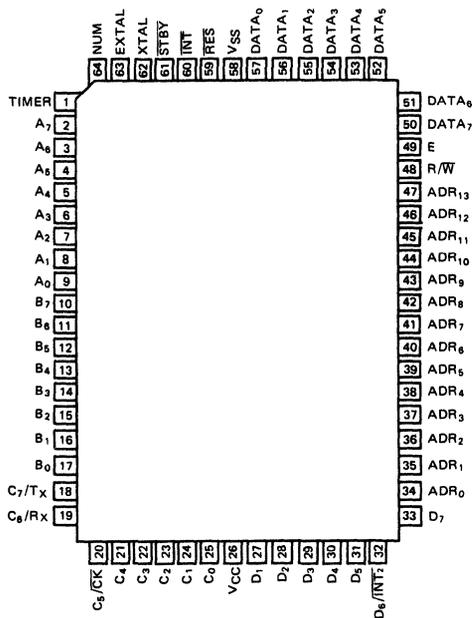
■ PIN ARRANGEMENT

● HD6305Y2P, HD63A05Y2P, HD63B05Y2P



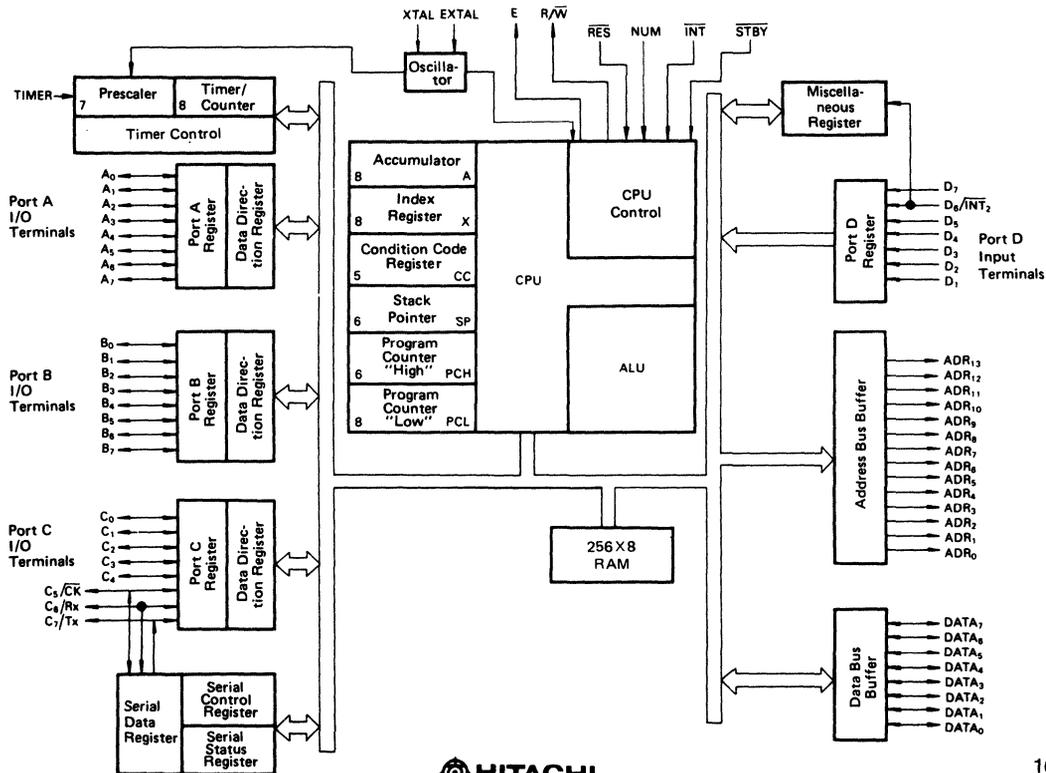
(Top View)

● HD6305Y2F, HD63A05Y2F, HD63B05Y2F



(Top View)

■ BLOCK DIAGRAM



■ ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Value	Unit
Supply Voltage	V _{CC}	-0.3 ~ +7.0	V
Input Voltage	V _{in}	-0.3 ~ V _{CC} + 0.3	V
Operating Temperature	T _{opr}	0 ~ +70	°C
Storage Temperature	T _{stg}	-55 ~ +150	°C

[NOTE] These products have a protection circuit in their input terminals against high electrostatic voltage or high electric fields. Notwithstanding, be careful not to apply any voltage higher than the absolute maximum rating to these high input impedance circuits. To assure normal operation, we recommended V_{in}, V_{out}: V_{SS} ≤ (V_{in} or V_{out}) ≤ V_{CC}.

■ ELECTRICAL CHARACTERISTICS

- DC CHARACTERISTICS (V_{CC} = 5.0V ± 10%, V_{SS} = 0V, Ta = 0 ~ +70°C, unless otherwise noted.)

Item	Symbol	Test Condition	min	typ	max	Unit		
Input "High" Voltage	RES, STBY	V _{IH}		V _{CC} -0.5	-	V _{CC} +0.3	V	
	EXTAL			V _{CC} ×0.7	-	V _{CC} +0.3		
	Other Inputs			2.0	-	V _{CC} +0.3		
Input "Low" Voltage	All Inputs	V _{IL}		-0.3	-	0.8	V	
Output "High" Voltage	All Outputs	V _{OH}		I _{OH} = -200μA	2.4	-	-	V
				I _{OH} = -10μA	V _{CC} -0.7	-	-	
Output "Low" Voltage	All Outputs	V _{OL}	I _{OL} = 1.6mA	-	-	0.55	V	
Input Leakage Current	TIMER, INT, D ₁ ~ D ₇ , STBY	I _{IL}		-	-	1.0	μA	
Three-state Current	A ₀ ~ A ₇ , B ₀ ~ B ₇ , C ₀ ~ C ₇ , ADR ₀ ~ ADR ₁₃ *, E*, R/W*	I _{TSI}	V _{in} = 0.5 ~ V _{CC} -0.5	-	-	1.0	μA	
Current Dissipation**	Operating	I _{CC}	f = 1MHz***	-	5	10	mA	
	Wait			-	2	5	mA	
	Stop			-	2	10	μA	
	Standby			-	2	10	μA	
Input Capacitance	All Terminals	C _{in}	f = 1MHz, V _{in} = 0V	-	-	12	pF	

* Only at standby

** V_{IH} min = V_{CC}-1.0V, V_{IL} max = 0.8V

*** The value at f = xMHz is given by using.

I_{CC} (f = xMHz) = I_{CC} (f = 1MHz) × x

- AC CHARACTERISTICS (V_{CC} = 5.0V ± 10%, V_{SS} = 0V, Ta = 0 ~ +70°C, unless otherwise noted.)

Item	Symbol	Test Condition	HD6305Y2			HD63A05Y2			HD63B05Y2			Unit
			min	typ	max	min	typ	max	min	typ	max	
Cycle Time	t _{cyc}	Fig. 1	1	-	10	0.666	-	10	0.5	-	10	μs
Enable Rise Time	t _{Er}		-	-	20	-	-	20	-	-	20	ns
Enable Fall Time	t _{Ef}		-	-	20	-	-	20	-	-	20	ns
Enable Pulse Width("High" Level)	PW _{EH}		450	-	-	300	-	-	220	-	-	ns
Enable Pulse Width("Low" Level)	PW _{EL}		450	-	-	300	-	-	220	-	-	ns
Address Delay Time	t _{AD}		-	-	250	-	-	190	-	-	TBD	ns
Address Hold Time	t _{AH}		20	-	-	20	-	-	20	-	-	ns
Data Delay Time	t _{DW}		-	-	250	-	-	160	-	-	TBD	ns
Data Hold Time (Write)	t _{HW}		20	-	-	20	-	-	20	-	-	ns
Data Set-up Time (Read)	t _{DSR}		80	-	-	60	-	-	TBD	-	-	ns
Data Hold Time (Read)	t _{HR}		0	-	-	0	-	-	0	-	-	ns

● **PORT TIMING** ($V_{CC} = 5.0V \pm 10\%$, $V_{SS} = 0V$, $T_a = 0 \sim +70^\circ C$, unless otherwise noted.)

Item	Symbol	Test Condition	HD6305Y2			HD63A05Y2			HD63B05Y2			Unit
			min	typ	max	min	typ	max	min	typ	max	
Port Data Set-up Time (Port A, B, C, D)	t_{PDS}	Fig. 2	200	—	—	200	—	—	200	—	—	ns
Port Data Hold Time (Port A, B, C, D)	t_{PDH}		200	—	—	200	—	—	200	—	—	ns
Port Data Delay Time (Port A, B, C)	t_{PDW}	Fig. 3	—	—	300	—	—	300	—	—	300	ns

● **CONTROL SIGNAL TIMING** ($V_{CC} = 5.0V \pm 10\%$, $V_{SS} = 0V$, $T_a = 0 \sim +70^\circ C$, unless otherwise noted.)

Item	Symbol	Test Condition	HD6305Y2			HD63A05Y2			HD63B05Y2			Unit
			min	typ	max	min	typ	max	min	typ	max	
\overline{INT} Pulse Width	t_{IWL}	Fig. 5	$t_{cyc} + 250$	—	—	$t_{cyc} + 200$	—	—	$t_{cyc} + 200$	—	—	ns
\overline{INT}_2 Pulse Width	t_{IWL2}		$t_{cyc} + 250$	—	—	$t_{cyc} + 200$	—	—	$t_{cyc} + 200$	—	—	ns
\overline{RES} Pulse Width	t_{RWL}		5	—	—	5	—	—	5	—	—	t_{cyc}
Control Set-up Time	t_{CS}	Fig. 5	250	—	—	250	—	—	250	—	—	ns
Timer Pulse Width	t_{TWL}		$t_{cyc} + 250$	—	—	$t_{cyc} + 200$	—	—	$t_{cyc} + 200$	—	—	ns
Oscillation Start Time (Crystal)	t_{OSC}	Fig.5, Fig.20*	—	—	20	—	—	20	—	—	20	ms
Reset Delay Time	t_{RHL}	Fig. 19	80	—	—	80	—	—	80	—	—	ms

* $C_L = 22pF \pm 20\%$, $R_s = 60\Omega$ max.

● **SCI TIMING** ($V_{CC} = 5.0V \pm 10\%$, $V_{SS} = 0V$, $T_a = 0 \sim +70^\circ C$, unless otherwise noted.)

Item	Symbol	Test Condition	HD6305Y2			HD63A05Y2			HD63B05Y2			Unit
			min	typ	max	min	typ	max	min	typ	max	
Clock Cycle	t_{Scyc}	Fig. 6, Fig. 7	1	—	32768	0.67	—	21845	0.5	—	16384	μs
Data Output Delay Time	t_{TXD}		—	—	250	—	—	250	—	—	250	ns
Data Set-up Time	t_{SRX}		200	—	—	200	—	—	200	—	—	ns
Data Hold Time	t_{HRX}		100	—	—	100	—	—	100	—	—	ns

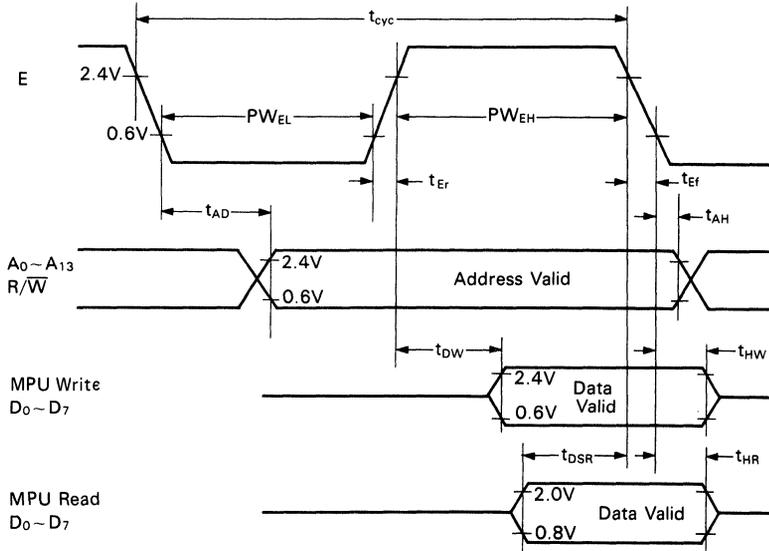


Figure 1 Bus Timing

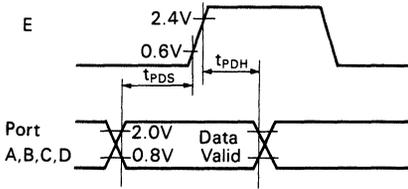


Figure 2 Port Data Set-up and Hold Times (MPU Read)

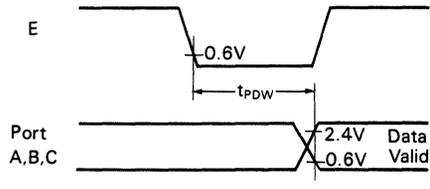


Figure 3 Port Data Delay Time (MPU Write)

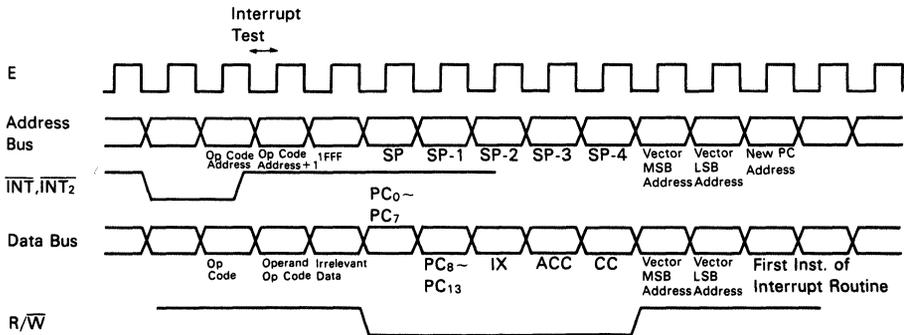


Figure 4 Interrupt Sequence

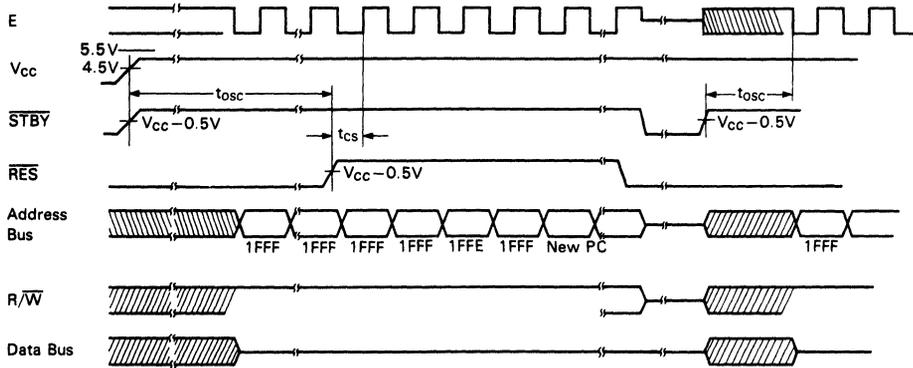


Figure5 Reset Timing

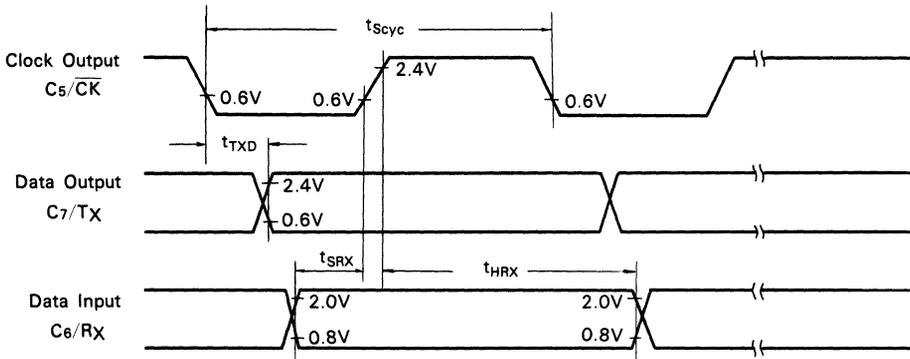


Figure6 SCI Timing (Internal Clock)

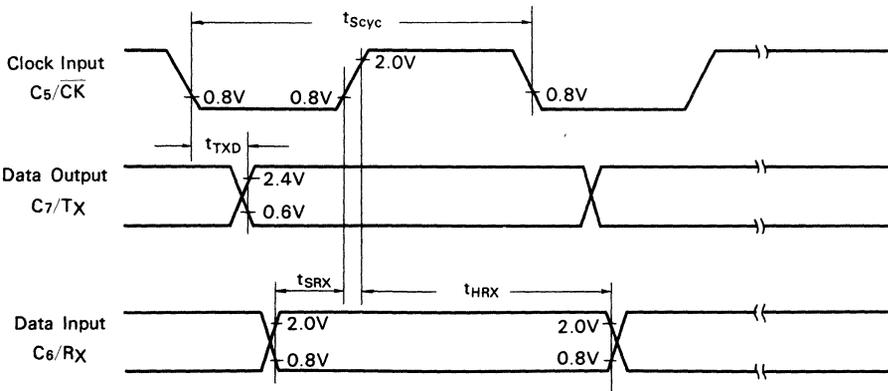
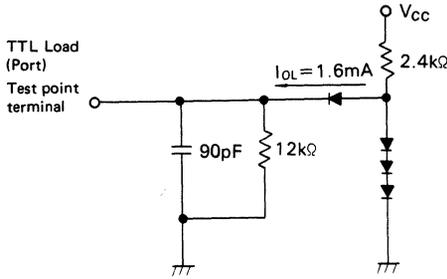


Figure7 SCI Timing(External Clock)



- [NOTES] 1. The load capacitance includes stray capacitance caused by the probe, etc.
 2. All diodes are 1S2074 (H).

Figure 8 Test Load

■ DESCRIPTION OF TERMINAL FUNCTIONS

The input and output signals of the MPU are described here.

● V_{CC}, V_{SS}

Voltage is applied to the MPU through these two terminals. V_{CC} is 5.0V ± 10%, while V_{SS} is grounded.

● \overline{INT} , \overline{INT}_2

External interrupt request inputs to the MPU. For details, refer to "INTERRUPT". The \overline{INT}_2 terminal is also used as the port D₆ terminal.

● XTAL, EXTAL

These terminals provide input to the on-chip clock circuit. A crystal oscillator (AT cut, 2.0 to 8.0 MHz) or ceramic filter is connected to the terminal. Refer to "INTERNAL OSCILLATOR" for using these input terminals.

● TIMER

This is an input terminal for event counter. Refer to "TIMER" for details.

● \overline{RES}

Used to reset the MPU. Refer to "RESET" for details.

● NUM

This terminal is not for user application. This terminal should be connected to V_{SS}.

● Enable (E)

This output terminal supplies E clock. Output is a single-phase, TTL compatible and 1/4 crystal oscillation frequency or 1/4 external clock frequency. It can drive one TTL load and a 90 pF condenser.

● Read/Write (R/ \overline{W})

This TTL compatible output signal indicates to peripheral and memory devices whether MPU is in Read ("High"), or in Write ("Low"). The normal standby state is Read ("High"). Its output can drive one TTL load and a 90pF condenser.

● Data Bus (DATA₀ ~ DATA₇)

This TTL compatible three-state buffer can drive one TTL load and 90pF.

● Address Bus (ADR₀ ~ ADR₁₃)

Each terminal is TTL compatible and can drive one TTL load and 90pF.

● Input/Output Terminals (A₀ ~ A₇, B₀ ~ B₇, C₀ ~ C₇)

These 24 terminals consist of four 8-bit I/O ports (A, B, C). Each of them can be used as an input or output terminal on a bit through program control of the data direction register. For details, refer to "I/O PORTS."

● Input Terminals (D₁ ~ D₇)

These seven input-only terminals are TTL or CMOS compatible. Of the port D's, D₆ is also used as \overline{INT}_2 . If D₆ is used as a port, the \overline{INT}_2 interrupt mask bit of the miscellaneous register must be set to "1" to prevent an \overline{INT}_2 interrupt from being accidentally accepted.

● \overline{STBY}

This terminal is used to place the MPU into the standby mode. With \overline{STBY} at "Low" level, the oscillation stops and the internal condition is reset. For details, refer to "Standby Mode."

The terminals described in the following are I/O pins for serial communication interface (SCI). They are also used as ports C₅, C₆ and C₇. For details, refer to "SERIAL COMMUNICATION INTERFACE."

● \overline{CK} (C₅)

Used to input or output clocks for serial operation.

● Rx (C₆)

Used to receive serial data.

● Tx (C₇)

Used to transmit serial data.

■ MEMORY MAP

The memory map of the MPU is shown in Fig. 9. During interrupt processing, the contents of the CPU registers are saved into the stack in the sequence shown in Fig. 10. This saving begins with the lower byte (PCL) of the program counter. Then the value of the stack pointer is decremented and the higher byte (PCH) of the program counter, index register (X), accumulator (A) and condition code register (CC) are stacked in that order. In a subroutine call, only the contents of the program counter (PCH and PCL) are stacked.

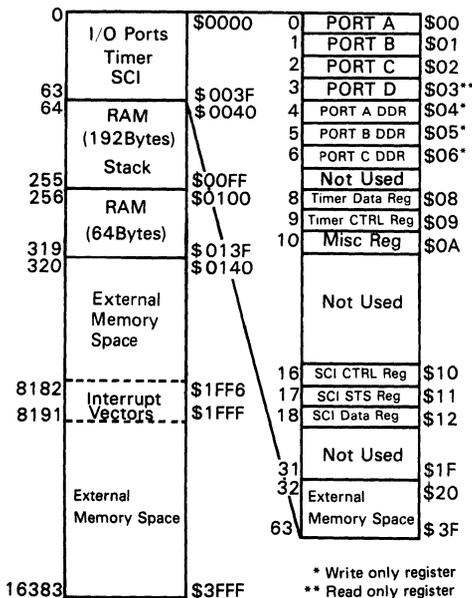
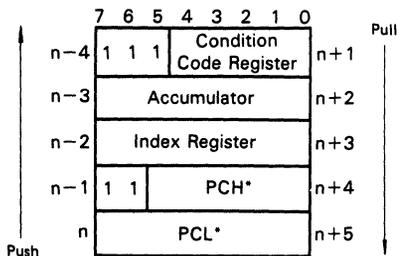


Figure 9 Memory Map of MPU



* In a subroutine call, only PCL and PCH are stacked.

Figure 10 Sequence of Interrupt Stacking

REGISTERS

There are five registers which the programmer can operate.

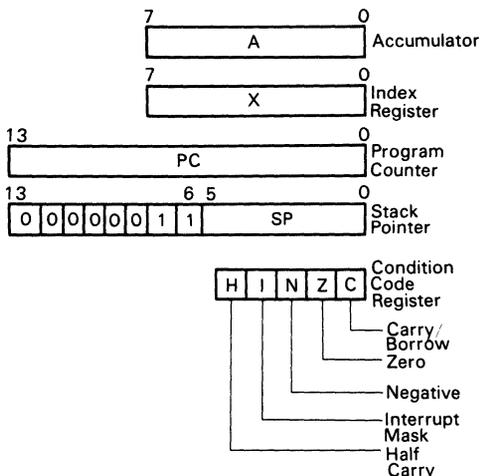


Figure 11 Programming Model

Accumulator (A)

This accumulator is an ordinary 8-bit register which holds operands or the result of arithmetic operation or data processing.

Index Register (X)

The index register is an 8-bit register, and is used for index addressing mode. Each of the addresses contained in the register consists of 8 bits which, combined with an offset value, provides an effective address.

In the case of a read/modify/write instruction, the index register can be used like an accumulator to hold operation data or the result of operation.

If not used in the index addressing mode, the register can be used to store data temporarily.

Program Counter (PC)

The program counter is a 14-bit register that contains the address of the next instruction to be executed.

Stack Pointer (SP)

The stack pointer is a 14-bit register that indicates the address of the next stacking space. Just after reset, the stack pointer is set at address \$00FF. It is decremented when data is pushed, and incremented when pulled. The upper 8 bits of the stack pointer are fixed to 00000011. During the MPU being reset or during a reset stack pointer (RSP) instruction, the pointer is set to address \$00FF. Since a subroutine or interrupt can use space up to address \$00C1 for stacking, the subroutine can be used up to 31 levels and the interrupt up to 12 levels.

Condition Code Register (CC)

The condition code register is a 5-bit register, each bit indicating the result of the instruction just executed. The bits can be individually tested by conditional branch instruc-

tions. The CC bits are as follows:

- Half Carry (H):** Used to indicate that a carry occurred between bits 3 and 4 during an arithmetic operation (ADD, ADC).
- Interrupt (I):** Setting this bit causes all interrupts, except a software interrupt, to be masked. If an interrupt occurs with the bit I set, it is latched. It will be processed the instant the interrupt mask bit is reset. (More specifically, it will enter the interrupt processing routine after the instruction following the CLI has been executed.)
- Negative (N):** Used to indicate that the result of the most recent arithmetic operation, logical operation or data processing is negative (bit 7 is logic "1").
- Zero (Z):** Used to indicate that the result of the most recent arithmetic operation, logical operation or data processing is zero.
- Carry/Borrow (C):** Represents a carry or borrow that occurred in the most recent arithmetic operation. This bit is also affected by the Bit Test and Branch instruction and a Rotate instruction.

■ INTERRUPT

There are six different types of interrupt: external interrupts (INT, INT₂), internal timer interrupts (TIMER, TIMER₂), serial interrupt (SCI) and interrupt by an instruction (SWI).

Of these six interrupts, the INT₂ and TIMER or the SCI and TIMER₂ generate the same vector address, respectively.

When an interrupt occurs, the program in progress stops and the then CPU status is saved onto the stack. And then, the interrupt mask bit (I) of the condition code register is set and the start address of the interrupt processing routine is obtained from a particular interrupt vector address. Then the interrupt routine starts from the start address. System can exit from the interrupt routine by an RTI instruction. When this instruction is executed, the CPU status before the interrupt (saved onto the stack) is pulled and the CPU restarts the sequence with the instruction next to the one at which the interrupt occurred. Table 1 lists the priority of interrupts and their vector addresses.

Table 1 Priority of Interrupts

Interrupt	Priority	Vector Address
RES	1	\$1FFE, \$1FFF
SWI	2	\$1FFC, \$1FFD
INT	3	\$1FFA, \$1FFB
TIMER/INT ₂	4	\$1FF8, \$1FF9
SCI/TIMER ₂	5	\$1FF6, \$1FF7

A flowchart of the interrupt sequence is shown in Fig. 12. A block diagram of the interrupt request source is shown in Fig. 13.

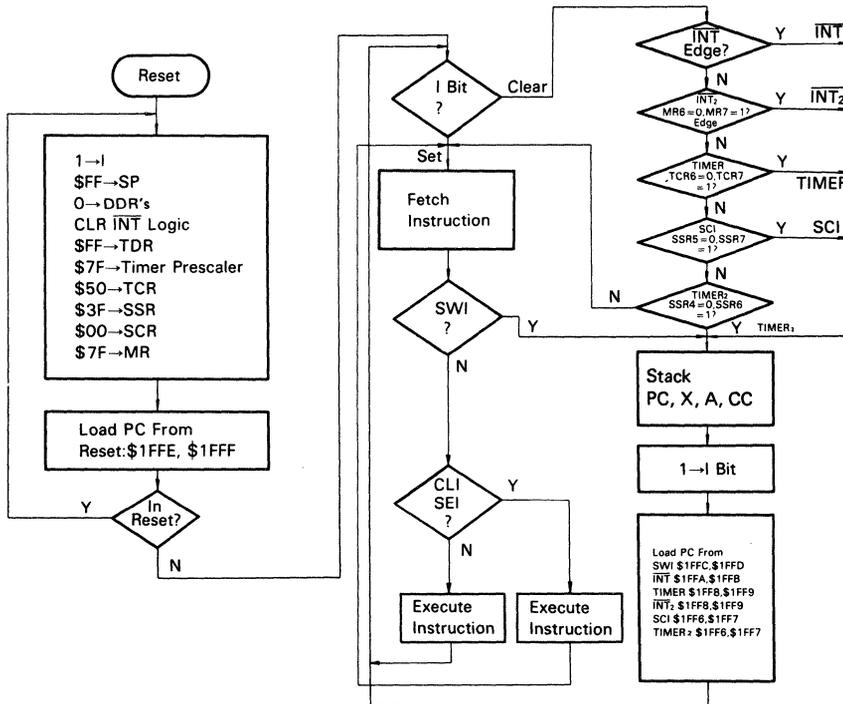


Figure 12 Interrupt Flow Chart

In the block diagram, both the external interrupts \overline{INT} and \overline{INT}_2 are edge trigger inputs. At the falling edge of each input, an interrupt request is generated and latched. The \overline{INT} interrupt request is automatically cleared if jumping is made to the \overline{INT} processing routine. Meanwhile, the \overline{INT}_2 request is cleared if "0" is written in bit 7 of the miscellaneous register.

For the external interrupts (\overline{INT} , \overline{INT}_2), internal timer interrupts (TIMER, $TIMER_2$) and serial interrupt (SCI), each interrupt request is held, but not processed, if the 1 bit of the condition code register is set. Immediately after the I bit is cleared, the corresponding interrupt processing starts according to the priority.

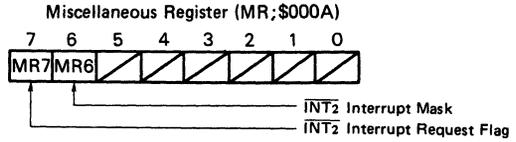
The \overline{INT}_2 interrupt can be masked by setting bit 6 of the miscellaneous register; the TIMER interrupt by setting bit 6 of the timer control register; the SCI interrupt by setting bit 5 of the serial status register; and the $TIMER_2$ interrupt by setting bit 4 of the serial status register.

The status of the \overline{INT} terminal can be tested by a BIL or BIH instruction. The \overline{INT} falling edge detector circuit and its latching circuit are independent of testing by these instructions. This is also true with the status of the \overline{INT}_2 terminal.

• **Miscellaneous Register (MR; \$000A)**

The interrupt vector address for the external interrupt \overline{INT}_2 is the same as that for the TIMER interrupt, as shown in Table 1. For this reason, a special register called the miscellaneous register (MR; \$000A) is available to control the \overline{INT}_2 interrupts.

Bit 7 of this register is the \overline{INT}_2 interrupt request flag. When the falling edge is detected at the \overline{INT}_2 terminal, "1" is set in bit 7. Then the software in the interrupt routine (vector addresses: \$1FF8, \$1FF9) checks bit 7 to see if it is \overline{INT}_2 interrupt. Bit 7 can be reset by software.



Bit 6 is the \overline{INT}_2 interrupt mask bit. If this bit is set to "1", then the \overline{INT}_2 interrupt is disabled. Both read and write are possible with bit 7 but "1" cannot be written in this bit by software. This means that an interrupt request by software is impossible.

When reset, bit 7 is cleared to "0" and bit 6 is set to "1".

■ **TIMER**

Figure 14 shows a MPU timer block diagram. The timer data register is loaded by software and, upon receipt of a clock input, begins to count down. When the timer data

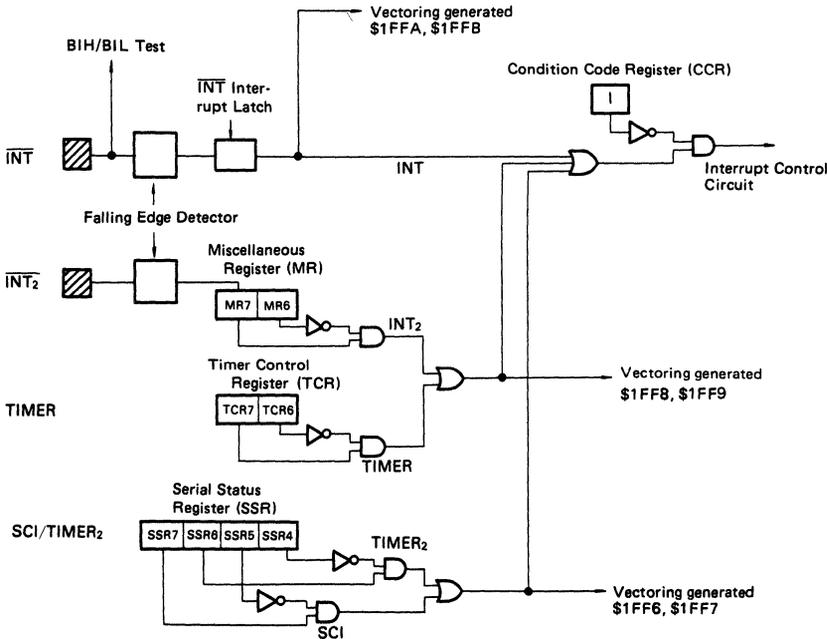


Figure 13 Interrupt Request Generation Circuitry

register (TDR) becomes "0", the timer interrupt request bit (bit 7) in the timer control register is set. In response to the interrupt request, the CPU saves its status into the stack and fetches timer interrupt routine address from addresses \$1FF8 and \$1FF9 and execute the interrupt routine. The timer interrupt can be masked by setting the timer interrupt mask bit (bit 6) in the timer control register. The mask bit (I) in the condition code register can also mask the timer interrupt.

The source clock to the timer can be either an external signal from the timer input terminal or the internal E signal (the oscillator clock divided by 4). If the E signal is used as the source, the clock input can be gated by the input to the timer input terminal.

Once the timer count has reached "0", it starts counting down with "\$FF". The count can be monitored whenever desired by reading the timer data register. This permits the program to know the length of time having passed after the occurrence of a timer interrupt, without disturbing the contents of the counter.

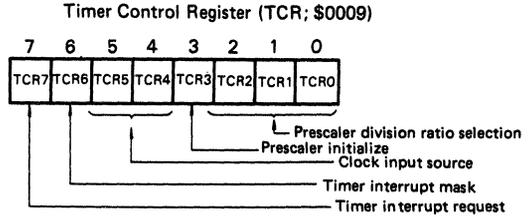
When the MPU is reset, both the prescaler and counter are initialized to logic "1". The timer interrupt request bit (bit 7) then is cleared and the timer interrupt mask bit (bit 6) is set.

To clear the timer interrupt request bit (bit 7), it is necessary to write "0" in that bit.

• Timer Control Register (TCR; \$0009)

Selection of a clock source, selection of a prescaler frequency division ratio, and a timer interrupt can be controlled by the timer control register (TCR; \$0009).

For the selection of a clock source, any one of the four modes (see Table 2) can be selected by bits 5 and 4 of the timer control register (TCR).



After reset, the TCR is initialized to "E under timer terminal control" (bit 5 = 0, bit 4 = 1). If the timer terminal is "1", the counter starts counting down with "\$FF" immediately after reset.

When "1" is written in bit 3, the prescaler is initialized. This bit always shows "0" when read.

TCR7	Timer interrupt request
0	Absent
1	Present
TCR6	Timer interrupt mask
0	Enabled
1	Disabled

Table 2 Clock Source Selection

TCR		Clock input source
Bit 5	Bit 4	
0	0	Internal clock E
0	1	E under timer terminal control
1	0	No clock input (counting stopped)
1	1	Event input from timer terminal

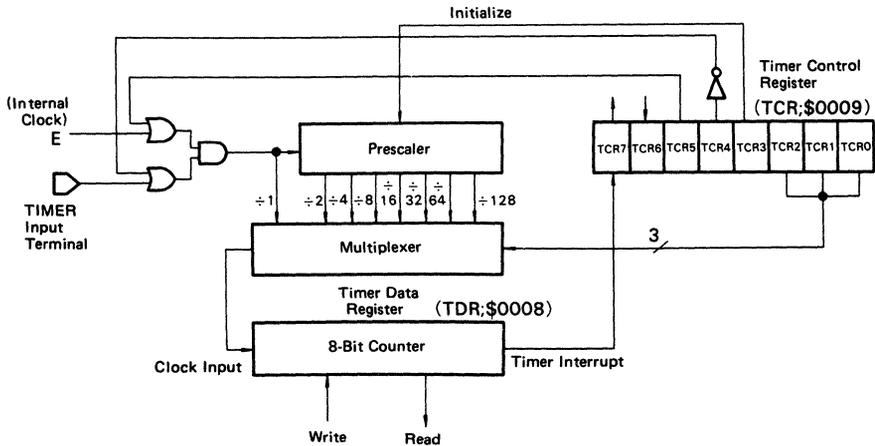


Figure 14 Timer Block Diagram

A prescaler division ratio is selected by the combination of three bits (bits 0, 1 and 2) of the timer control register (see Table 3). There are eight different division ratios: ÷1, ÷2, ÷4, ÷8, ÷16, ÷32, ÷64 and ÷128. After reset, the TCR is set to the ÷1 mode.

Table 3 Prescaler Division Ratio Selection

TCR			Prescaler division ratio
Bit 2	Bit 1	Bit 0	
0	0	0	÷1
0	0	1	÷2
0	1	0	÷4
0	1	1	÷8
1	0	0	÷16
1	0	1	÷32
1	1	0	÷64
1	1	1	÷128

A timer interrupt is enabled when the timer interrupt mask bit is "0", and disabled when the bit is "1". When a timer interrupt occurs, "1" is set in the timer interrupt request bit. This bit can be cleared by writing "0" in that bit.

■ SERIAL COMMUNICATION INTERFACE (SCI)

This interface is used for serial transmission or reception of 8-bit data. Sixteen transfer rates are available in the range from 1 μs to approx. 32 ms (for oscillation at 4 MHz).

The SCI consists of three registers, one eighth counter and one prescaler. (See Fig. 15.) SCI communicates with the CPU via the data bus, and with the outside world through bits 5, 6 and 7 of port C. Described below are the operations of each register and data transfer.

● SCI Control Register (SCR; \$0010)

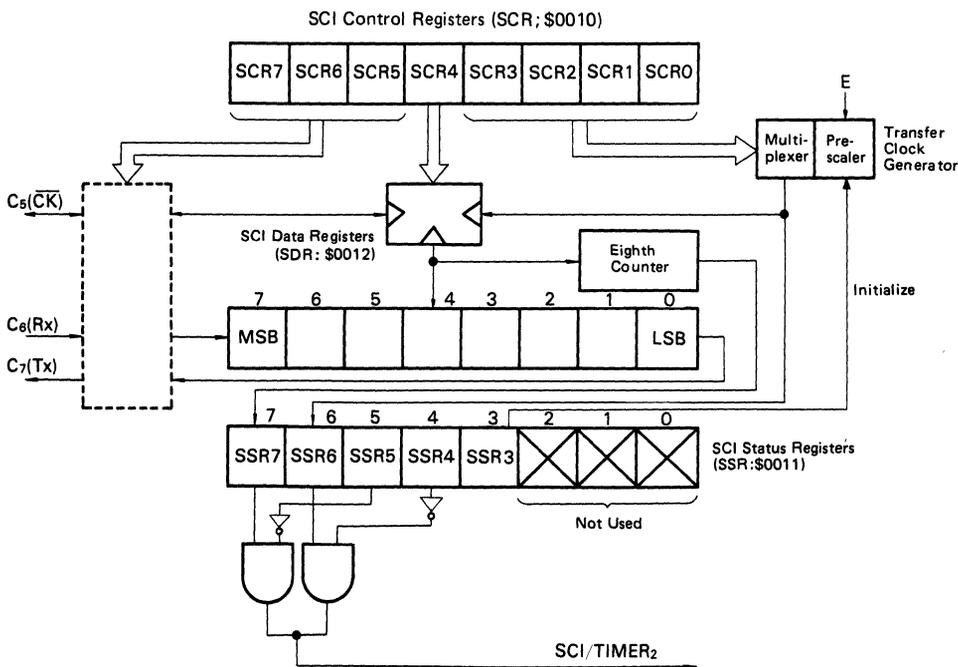
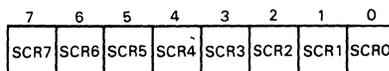


Figure 15 SCI Block Diagram

SCR7	C ₇ terminal
0	Used as I/O terminal (by DDR).
1	Serial data output (DDR output)

SCR6	C ₆ terminal
0	Used as I/O terminal (by DDR).
1	Serial data input (DDR input)

SCR5	SCR4	Clock source	C ₅ terminal
0	0	—	Used as I/O terminal (by DDR).
0	1	—	
1	0	Internal	Clock output (DDR output)
1	1	External	Clock input (DDR input)

Bit 7 (SCR7)

When this bit is set, the DDR corresponding to the C₇ becomes "1" and this terminal serves for output of SCI data. After reset, the bit is cleared to "0".

Bit 6 (SCR6)

When this bit is set, the DDR corresponding to the C₆ becomes "0" and this terminal serves for input of SCI data. After reset, the bit is cleared to "0".

Bits 5 and 4 (SCR5, SCR4)

These bits are used to select a clock source. After reset, the bits are cleared to "0".

Bits 3 ~ 0 (SCR3 ~ SCR0)

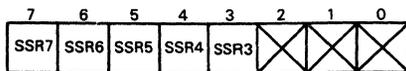
These bits are used to select a transfer clock rate. After reset, the bits are cleared to "0".

SCR3	SCR2	SCR1	SCR0	Transfer clock rate	
				4.00 MHz	4.194 MHz
0	0	0	0	1 μs	0.95 μs
0	0	0	1	2 μs	1.91 μs
0	0	1	0	4 μs	3.82 μs
0	0	1	1	8 μs	7.64 μs
?	?	?	?	?	?
1	1	1	1	32768 μs	1/32 s

•SCI Data Register (SDR; \$0012)

A serial-parallel conversion register that is used for transfer of data.

•SCI Status Register (SSR; \$0011)



Bit 7 (SSR7)

Bit 7 is the SCI interrupt request bit which is set upon completion of transmitting or receiving 8-bit data. It is cleared when reset or data is written to or read from the SCI data register with the SCR5="1". The bit can also be cleared by writing "0" in it.

Bit 6 (SSR6)

Bit 6 is the TIMER₂ interrupt request bit. TIMER₂ is used commonly with the serial clock generator, and SSR6 is set each time the internal transfer clock falls. When reset, the bit is cleared. It also be cleared by writing "0" in it. (For details, see TIMER₂.)

Bit 5 (SSR5)

Bit 5 is the SCI interrupt mask bit which can be set or cleared by software. When it is "1", the SCI interrupt (SSR7) is masked. When reset, it is set to "1".

Bit 4 (SSR4)

Bit 4 is the TIMER₂ interrupt mask bit which can be set or cleared by software. When the bit is "1", the TIMER₂ interrupt (SSR6) is masked. When reset, it is set to "1".

Bit 3 (SSR3)

When "1" is written in this bit, the prescaler of the transfer clock generator is initialized. When read, the bit always is "0".

Bits 2 ~ 0

Not used.

SSR7	SCI interrupt request
0	Absent
1	Present

SSR6	TIMER ₂ interrupt request
0	Absent
1	Present

SSR5	SCI interrupt mask
0	Enabled
1	Disabled

SSR4	TIMER ₂ interrupt mask
0	Enabled
1	Disabled

•Data Transmission

By writing the desired control bits into the SCI control registers, a transfer rate and a source of transfer clock are determined and bits 7 and 5 of port C are set at the serial data output terminal and the serial clock terminal, respectively. The transmit data should be stored from the accumulator or index register into the SCI data register. The data written in the SCI data register is output from the C₇/Tx terminal, starting with the LSB, synchronously with the falling edge of the serial clock. (See Fig. 16.) When 8 bit of

data have been transmitted, the interrupt request bit is set in bit 7 of the SCI status register with the rising edge of the last serial clock. This request can be masked by setting bit 5 of the SCI status register. Once the data has been sent, the 8th bit data (MSB) stays at the C₇/Tx terminal. If an external clock source has been selected, the transfer rate determined by bits 0 ~ 3 of the SCI control register is ignored, and the C_s/ \overline{CK} terminal is set as input. If the internal clock has been selected, the C_s/ \overline{CK} terminal is set as output and clocks are output at the transfer rate selected by bits 0 ~ 3 of the SCI control register.

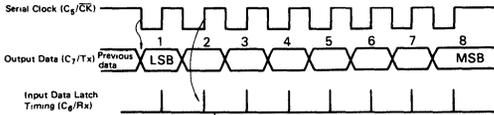


Figure 16 SCI Timing Chart

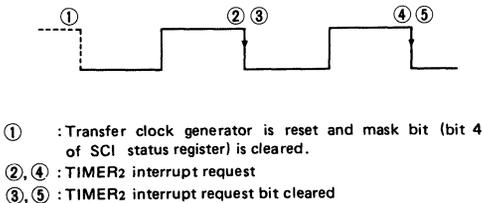
• Data Reception

By writing the desired control bits into the SCI control register, a transfer rate and a source of transfer clock are determined and bit 6 and 5 of port C are set at the serial data input terminal and the serial clock terminal, respectively. Then dummy-writing or -reading the SCI data register, the system is ready for receiving data. (This procedure is not needed after reading the subsequent received data. It must be taken after reset and after not reading the subsequent received.)

The data from the C₆/Rx terminal is input to the SCI data register synchronously with the rising edge of the serial clock (see Fig. 16). When 8 bits of data have been received, the interrupt request bit is set in bit 7 of the SCI status register. This request can be masked by setting bit 5 of the SCI status register. If an external clock source has been selected, the transfer rate determined by bits 0 ~ 3 of the SCI control register is ignored and the data is received synchronously with the clock from the C_s/ \overline{CK} terminal. If the internal clock has been selected, the C_s/ \overline{CK} terminal is set as output and clocks are output at the transfer rate selected by bits 0 ~ 3 of the SCI control register.

• TIMER₂

The SCI transfer clock generator can be used as a timer. The clock selected by bits 3 ~ 0 of the SCI control register (4μs ~ approx. 32 ms (for oscillation at 4 MHz)) is input to bit 6 of the SCI status register and the TIMER₂ interrupt request bit is set at each falling edge of the clock. Since interrupt requests occur periodically, TIMER₂ can be used as a reload counter or clock.



Bit of data direction register	Bit of output data	Status of output	Input to CPU
1	0	0	0
1	1	1	1
0	X	3-state	Pin

Figure 17 Input/Output Port Diagram

Seven input-only terminals are available (port D). Writing to an input terminal is invalid.

All input/output terminals and input terminals are TTL compatible and CMOS compatible in respect of both input and output.

If I/O ports or input ports are not used, they should be connected to V_{SS} via resistors. With none connected to these terminals, there is the possibility of power being consumed despite that they are not used.

■ RESET

The MPU can be reset either by external reset input (\overline{RES}) or power-on reset. (See Fig. 18.) On power up, the reset input must be held "Low" for at least t_{OSC} to assure that the internal oscillator is stabilized. A sufficient time of delay can be obtained by connecting a capacitance to the \overline{RES} input as shown in Fig. 19.

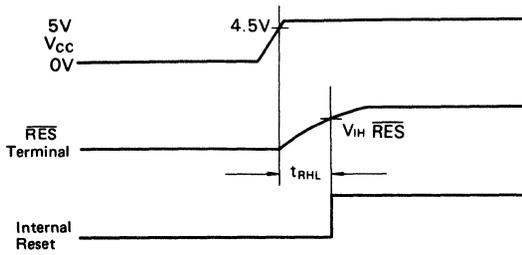


Figure 18 Power On and Reset Timing

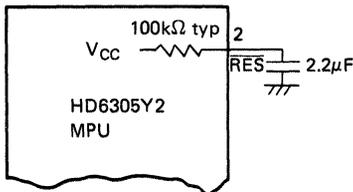


Figure 19 Input Reset Delay Circuit

INTERNAL OSCILLATOR

The internal oscillator circuit is designed to meet the

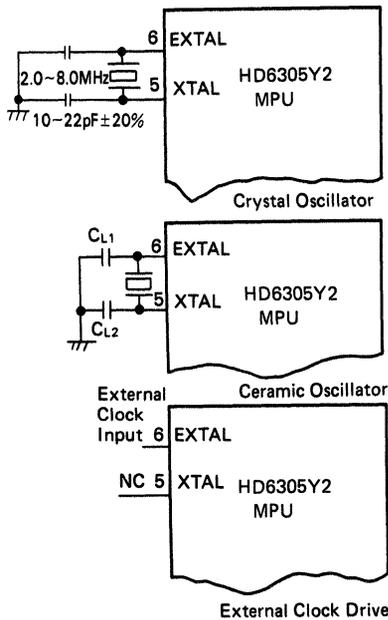


Figure 20 Internal Oscillator Circuit

requirement for minimum external configurations. It can be driven by connecting a crystal (AT cut 2.0 ~ 8.0MHz) or ceramic oscillator between pins 5 and 6 depending on the required oscillation frequency stability.

Three different terminal connections are shown in Fig. 20. Figs. 21 and 22 illustrate the specifications and typical arrangement of the crystal, respectively.

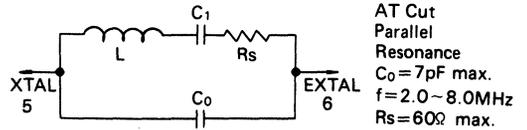
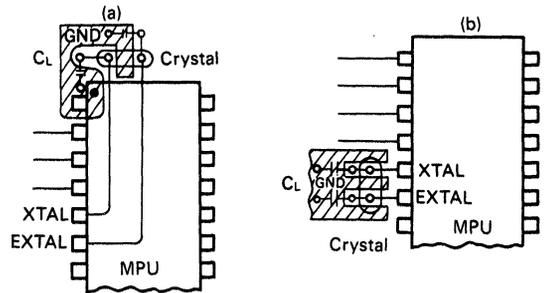


Figure 21 Parameters of Crystal



[NOTE] Use as short wirings as possible for connection of the crystal with the EXTAL and XTAL terminals. Do not allow these wirings to cross others.

Figure 22 Typical Crystal Arrangement

LOW POWER DISSIPATION MODE

The HD6305Y2 has three low power dissipation modes: wait, stop and standby.

Wait Mode

When WAIT instruction being executed, the MPU enters into the wait mode. In this mode, the oscillator stays active but the internal clock stops. The CPU stops but the peripheral functions – the timer and the serial communication interface – stay active. (NOTE: Once the system has entered the wait mode, the serial communication interface can no longer be retriggered.) In the wait mode, the registers, RAM and I/O terminals hold their condition just before entering into the wait mode.

The escape from this mode can be done by interrupt (\overline{INT} , $TIMER/INT_2$ or $SCI/TIMER_2$), \overline{RES} or \overline{STBY} . The \overline{RES} resets the MPU and the \overline{STBY} brings it into the standby mode. (This will be mentioned later.)

When interrupt is requested to the CPU and accepted, the wait mode escapes, then the CPU is brought to the operation mode and vectors to the interrupt routine. If the interrupt is masked by the I bit of the condition code register, after releasing from the wait mode the MPU executes the instruction next to the WAIT. If an interrupt other than the \overline{INT} (i.e., $TIMER/INT_2$ or $SCI/TIMER_2$) is masked by the timer control

register, miscellaneous register or serial status register, there is no interrupt request to the CPU, so the wait mode cannot be released.

Fig. 23 shows a flowchart for the wait function.

• Stop Mode

When STOP instruction being executed, MPU enters into the stop mode. In this mode, the oscillator stops and the CPU and peripheral functions become inactive but the RAM, registers and I/O terminals hold their condition just before entering into the stop mode.

The escape from this mode can be done by an external interrupt ($\overline{\text{INT}}$ or $\overline{\text{INT}}_2$), $\overline{\text{RES}}$ or $\overline{\text{STBY}}$. The $\overline{\text{RES}}$ resets the MPU and the $\overline{\text{STBY}}$ brings into the standby mode.

When interrupt is requested to the CPU and accepted, the stop mode escapes, then the CPU is brought to the operation mode and vectors to the interrupt routine. If the interrupt is masked by the I bit of the condition code register, after releasing from the stop mode, the MPU executes the instruction next to the STOP. If the $\overline{\text{INT}}_2$ interrupt is masked by the miscellaneous register, there is no interrupt request to the MPU, so the stop mode cannot be released.

Fig. 24 shows a flowchart for the stop function. Fig. 25 shows a timing chart of return to the operation mode from the stop mode.

For releasing from the stop mode by an interrupt, oscillation starts upon input of the interrupt and, after the internal delay time for stabilized oscillation, the CPU becomes active. For restarting by $\overline{\text{RES}}$, oscillation starts when the $\overline{\text{RES}}$ goes "0" and the CPU restarts when the $\overline{\text{RES}}$ goes "1". The duration of $\text{RES}="0"$ must exceed 30 ms to assure stabilized oscillation.

• Standby Mode

The MPU enters into the standby mode when the $\overline{\text{STBY}}$ terminal goes "Low". In this mode, all operations stop and the internal condition is reset but the contents of the RAM are hold. The I/O terminals turn to high-impedance state. The standby mode should escape by bringing $\overline{\text{STBY}}$ "High". The CPU must be restarted by reset. The timing of input signals at the $\overline{\text{RES}}$ and $\overline{\text{STBY}}$ terminals is shown in Fig. 26.

Table 4 lists the status of each parts of the MPU in each low power dissipation modes. Transitions between each mode are shown in Fig. 27.

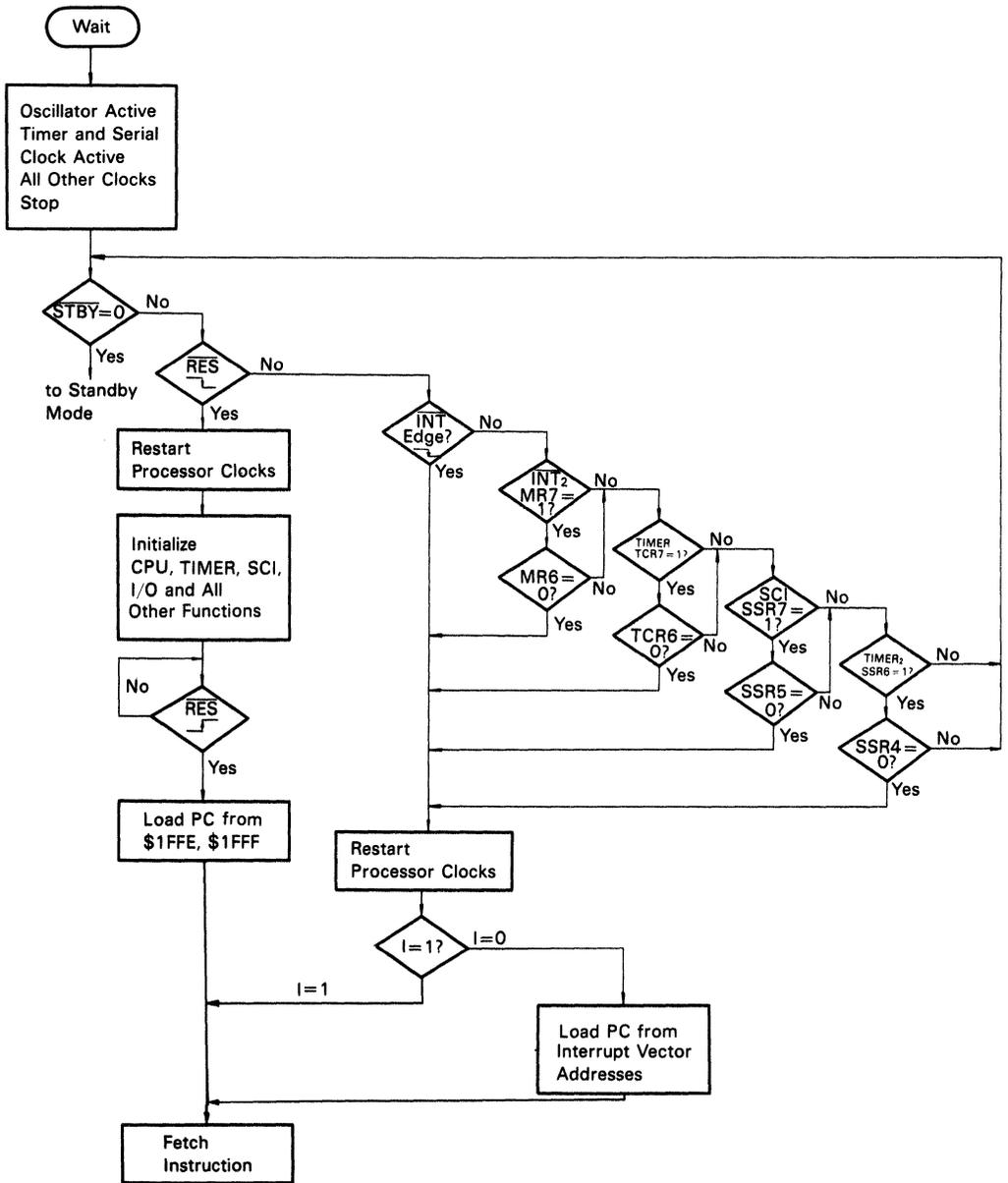


Figure 23 Wait Mode Flow Chart

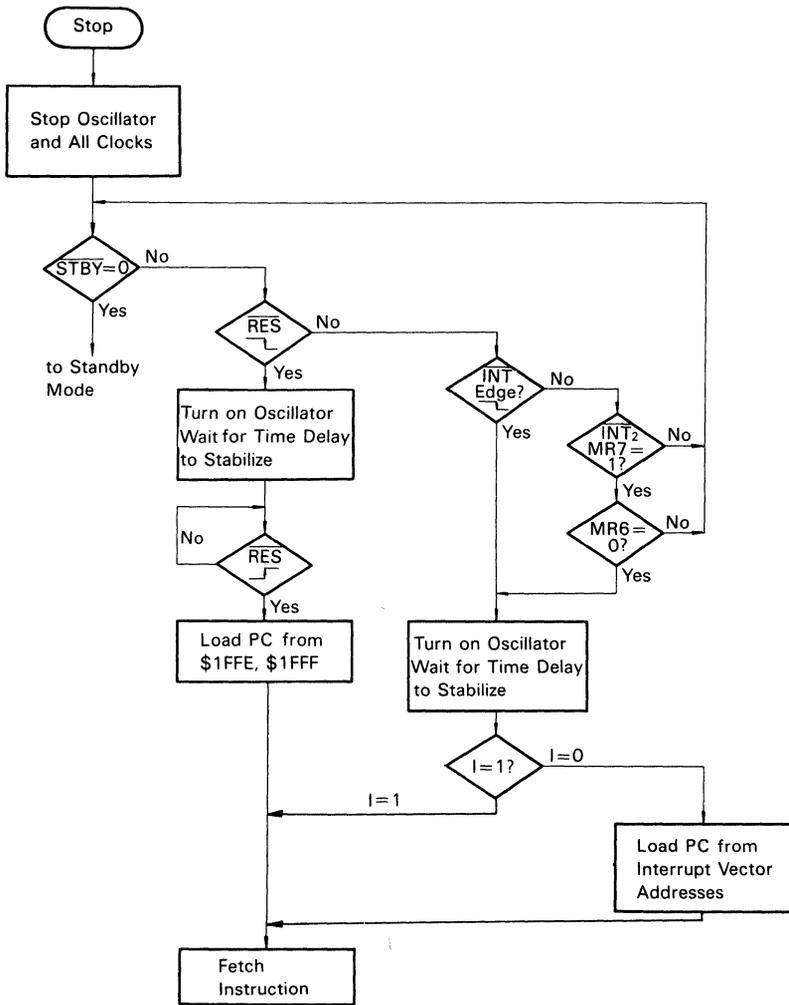


Figure 24 Stop Mode Flow Chart

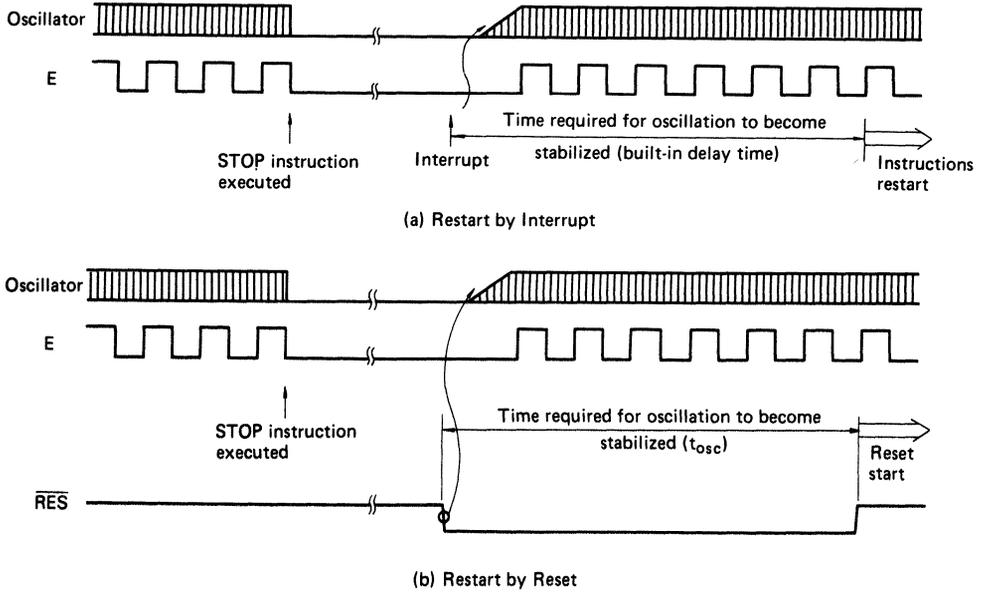


Figure 25 Timing Chart of Releasing from Stop Mode

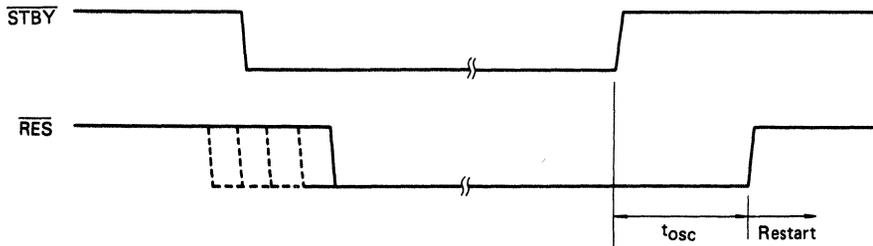


Figure 26 Timing Chart of Releasing from Standby Mode

Table 4 Status of Each Part of MPU in Low Power Dissipation Modes

Mode	Start		Condition						Escape
			Oscillator	CPU	Timer, Serial	Register	RAM	I/O terminal	
WAIT	Software	WAIT instruction	Active	Stop	Active	Keep	Keep	Keep	STBY, RES, INT ₁ , INT ₂ , each interrupt request of TIMER, TIMER ₂ , SCI
STOP		STOP instruction	Stop	Stop	Stop	Keep	Keep	Keep	STBY, RES, INT ₁ , INT ₂
Stand-by	Hardware	STBY="Low"	Stop	Stop	Stop	Reset	Keep	High impedance	STBY="High"

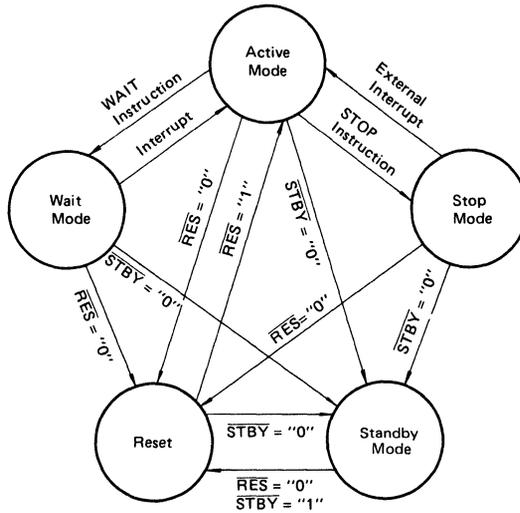


Figure 27 Transitions among Active Mode, Wait Mode, Stop Mode, Standby Mode and Reset

■ BIT MANIPULATION

The MPU can use a single instruction (BSET or BCLR) to set or clear one bit of the RAM within page 0 or an I/O port (except the write-only registers such as the data direction register). Every bit of memory or I/O within page 0 (\$00 ~ \$FF) can be tested by the BRSET or BRCLR instruction; depending on the result of the test, the program can branch to required destinations. Since bits in the RAM on page 0, or I/O can be manipulated, the user may use a bit within the RAM on page 0 as a flag or handle a single I/O bit as an independent I/O terminal. Fig. 28 shows an example of bit manipulation and the validity of test instructions. In the example, the program is configured assuming that bit 0 of port A is connected to a zero cross detector circuit and bit 1 of the same port to the trigger of a triac.

The program shown can activate the triac within a time of 10μs from zero-crossing through the use of only 7 bytes on the memory. The on-chip timer provides a required time of delay and pulse width modulation of power is also possible.

```

SELF 1.  BRCLR 0, PORT A, SELF 1
        BSET 1, PORT A
        BCLR 1, PORT A
        ...
    
```

Figure 28 Example of Bit Manipulation

■ ADDRESSING MODES

Ten different addressing modes are available to the MPU.

● Immediate

See Fig. 29. The immediate addressing mode provides access to a constant which does not vary during execution of the program.

This access requires an instruction length of 2 bytes. The

effective address (EA) is PC and the operand is fetched from the byte that follows the operation code.

● Direct

See Fig. 30. In the direct addressing mode, the address of the operand is contained in the 2nd byte of the instruction. The user can gain direct access to memory up to the lower 255th address. 192 byte RAM and I/O registers are on page 0 of address space so that the direct addressing mode may be utilized.

● Extended

See Fig. 31. The extended addressing is used for referencing to all addresses of memory. The EA is the contents of the 2 bytes that follow the operation code. An extended addressing instruction requires a length of 3 bytes.

● Relative

See Fig. 32. The relative addressing mode is used with branch instructions only. When a branch occurs, the program counter is loaded with the contents of the byte following the operation code. $EA = (PC) + 2 + Rel.$, where Rel. indicates a signed 8-bit data following the operation code. If no branch occurs, Rel. = 0. When a branch occurs, the program jumps to any byte in the range +129 to -127. A branch instruction requires a length of 2 bytes.

● Indexed (No Offset)

See Fig. 33. The indexed addressing mode allows access up to the lower 255th address of memory. In this mode, an instruction requires a length of one byte. The EA is the contents of the index register.

• Indexed (8-bit Offset)

See Fig. 34. The EA is the contents of the byte following the operation code, plus the contents of the index register. This mode allows access up to the lower 511th address of memory. Each instruction when used in the index addressing mode (8-bit offset) requires a length of 2 bytes.

• Indexed (16-bit Offset)

See Fig. 35. The contents of the 2 bytes following the operation code are added to content of the index register to compute the value of EA. In this mode, the complete memory can be accessed. When used in the indexed addressing mode (16-bit offset), an instruction must be 3 bytes long.

• Bit Set/Clear

See Fig. 36. This addressing mode is applied to the BSET and BCLR instructions that can set or clear any bit on page 0. The lower 3 bits of the operation code specify the bit to be set or cleared. The byte that follows the operation code indicates an address within page 0.

• Bit Test and Branch

See Fig. 37. This addressing mode is applied to the BRSET and BRCLR instructions that can test any bit within page 0 and can be branched in the relative addressing mode. The byte to be tested is addressed depending on the contents of the byte following the operation code. Individual bits within the byte to be tested are specified by the lower 3 bits of the operation code. The 3rd byte represents a relative value which will be added to the program counter when a branch condition is established. Each of these instructions should be 3 bytes long. The value of the test bit is written in the carry bit of the condition code register.

• Implied

See Fig. 38. This mode involves no EA. All information needed for execution of an instruction is contained in the operation code. Direct manipulation on the accumulator and index register is included in the implied addressing mode. Other instructions such as SWI and RTI are also used in this mode. All instructions used in the implied addressing mode should have a length of one byte.

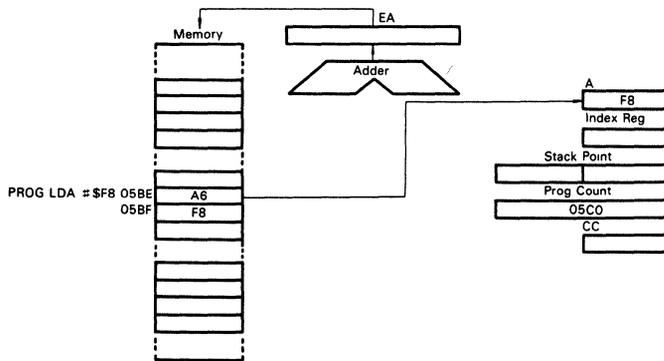


Figure 29 Example of Immediate Addressing

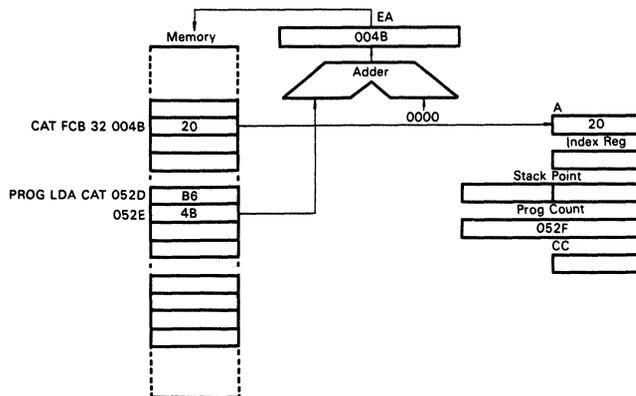


Figure 30 Example of Direct Addressing

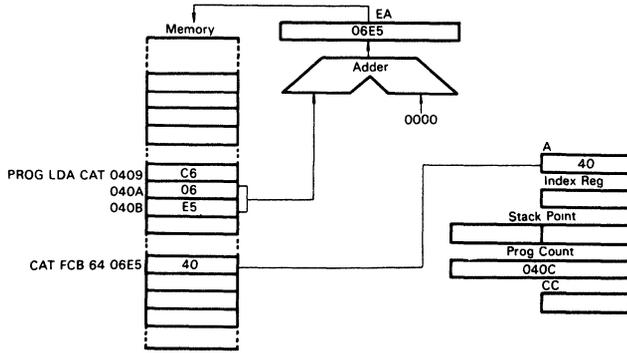


Figure 31 Example of Extended Addressing

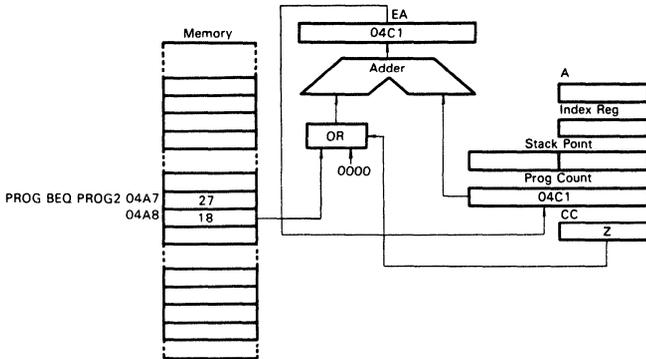


Figure 32 Example of Relative Addressing

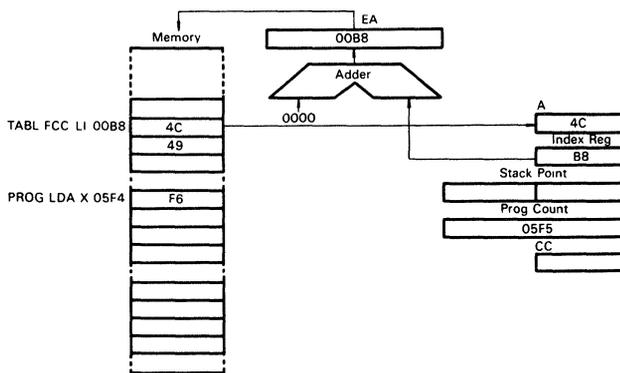


Figure 33 Example of Indexed (No Offset) Addressing

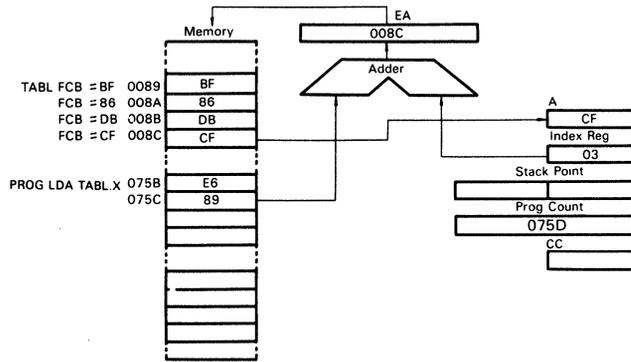


Figure 34 Example of Index (8-bit Offset) Addressing

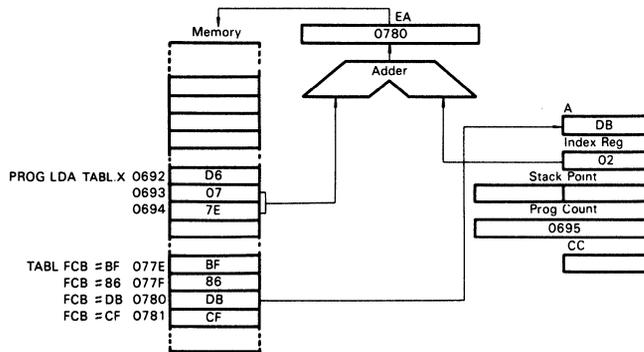


Figure 35 Example of Index (16-bit Offset) Addressing

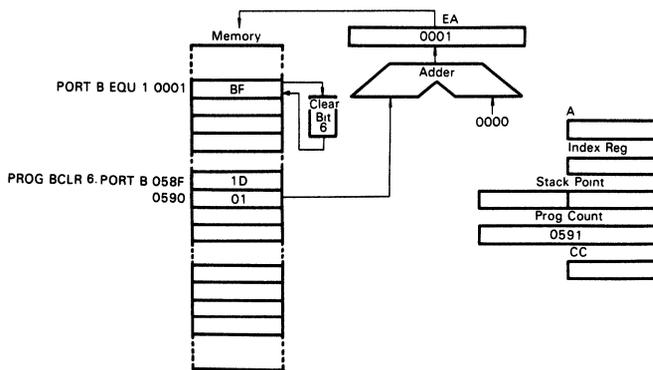


Figure 36 Example of Bit Set/Clear Addressing

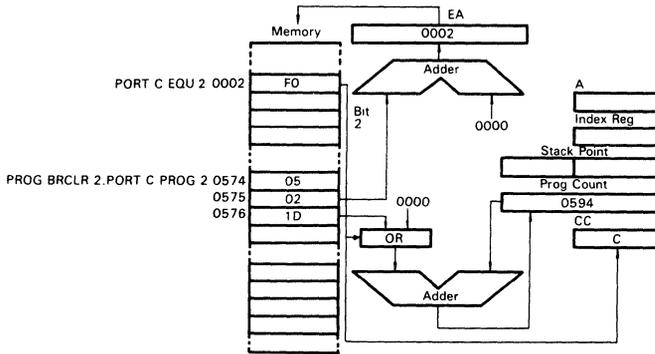


Figure 37 Example of Bit Test and Branch Addressing

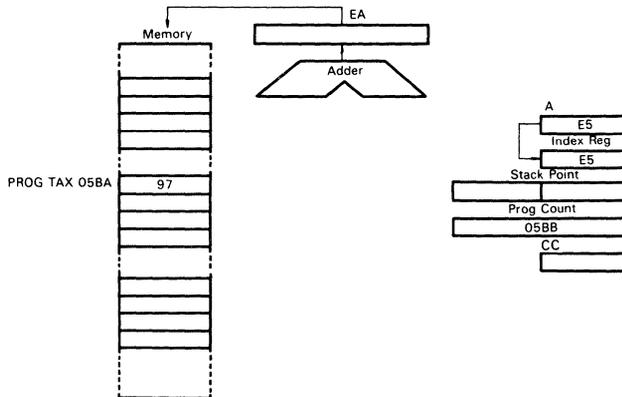


Figure 38 Example of Implied Addressing

■ INSTRUCTION SET

There are 62 basic instructions available to the HD6305Y2 MPU. They can be classified into five categories: register/memory, read/modify/write, branch, bit manipulation, and control. The details of each instruction are described in Tables 5 through 11.

● Register/Memory Instructions

Most of these instructions use two operands. One operand is either an accumulator or index register. The other is derived from memory using one of the addressing modes used on the HD6305Y2 MPU. There is no register operand in the unconditional jump instruction (JMP) and the subroutine jump instruction (JSR). See Table 5.

● Read/Modify/Write Instructions

These instructions read a memory or register, then modify or test its contents, and write the modified value into the memory or register. Zero test instruction (TST) does not write data, and is handled as an exception in the read/modify/write group. See Table 6.

● Branch Instructions

A branch instruction branches from the program sequence in progress if a particular condition is established. See Table 7.

● Bit Manipulation Instructions

These instructions can be used with any bit located up to the lower 255th address of memory. Two groups are available; one for setting or clearing and the other for bit testing and branching. See Table 8.

● Control Instructions

The control instructions control the operation of the MPU which is executing a program. See Table 9.

● List of Instructions in Alphabetical Order

Table 10 lists all the instructions used on the HD6305Y2 MPU in the alphabetical order.

● Operation Code Map

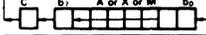
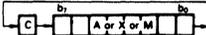
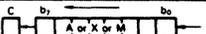
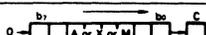
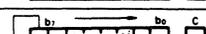
Table 11 shows the operation code map for the instructions used on the MPU.

Table 5 Register/Memory Instructions

Operations	Mnemonic	Addressing Modes												Boolean/ Arithmetic Operation	Condition Code										
		Immediate			Direct			Extended			Indexed (No Offset)				Indexed (8-Bit Offset)			Indexed (16-Bit Offset)			H	I	N	Z	C
		OP	#	~	OP	#	~	OP	#	~	OP	#	~		OP	#	~	OP	#	~					
Load A from Memory	LDA	A6	2	2	B6	2	3	C6	3	4	F6	1	3	E6	2	4	D6	3	5	M→A	●	●	^	^	●
Load X from Memory	LDX	AE	2	2	BE	2	3	CE	3	4	FE	1	3	EE	2	4	DE	3	5	M→X	●	●	^	^	●
Store A in Memory	STA				B7	2	3	C7	3	4	F7	1	4	E7	2	4	D7	3	5	A→M	●	●	^	^	●
Store X in Memory	STX				BF	2	3	CF	3	4	FF	1	4	EF	2	4	DF	3	5	X→M	●	●	^	^	●
Add Memory to A	ADD	AB	2	2	BB	2	3	CB	3	4	FB	1	3	EB	2	4	DB	3	5	A+M→A	^	●	^	^	^
Add Memory and Carry to A	ADC	A9	2	2	B9	2	3	C9	3	4	F9	1	3	E9	2	4	D9	3	5	A+M+C→A	^	●	^	^	^
Subtract Memory	SUB	A0	2	2	B0	2	3	C0	3	4	F0	1	3	E0	2	4	D0	3	5	A-M→A	●	●	^	^	^
Subtract Memory from A with Borrow	SBC	A2	2	2	B2	2	3	C2	3	4	F2	1	3	E2	2	4	D2	3	5	A-M-C→A	●	●	^	^	^
AND Memory to A	AND	A4	2	2	B4	2	3	C4	3	4	F4	1	3	E4	2	4	D4	3	5	A·M→A	●	●	^	^	●
OR Memory with A	ORA	AA	2	2	BA	2	3	CA	3	4	FA	1	3	EA	2	4	DA	3	5	A+M→A	●	●	^	^	●
Exclusive OR Memory with A	EOR	A8	2	2	B8	2	3	C8	3	4	F8	1	3	E8	2	4	D8	3	5	A+M→A	●	●	^	^	●
Arithmetic Compare A with Memory	CMP	A1	2	2	B1	2	3	C1	3	4	F1	1	3	E1	2	4	D1	3	5	A-M	●	●	^	^	^
Arithmetic Compare X with Memory	CPX	A3	2	2	B3	2	3	C3	3	4	F3	1	3	E3	2	4	D3	3	5	X-M	●	●	^	^	^
Bit Test Memory with A (Logical Compare)	BIT	A5	2	2	B5	2	3	C5	3	4	F5	1	3	E5	2	4	D5	3	5	A·M	●	●	^	^	●
Jump Unconditional	JMP				BC	2	2	CC	3	3	FC	1	2	EC	2	3	DC	3	4		●	●	●	●	●
Jump to Subroutine	JSR				BD	2	5	CD	3	6	FD	1	5	ED	2	5	DD	3	6		●	●	●	●	●

Symbols: Op = Operation
 # = Number of bytes
 ~ = Number of cycles

Table 6 Read/Modify/Write Instructions

Operations	Mnemonic	Addressing Modes										Boolean/Arithmetic Operation	Condition Code									
		Implied(A)		Implied(X)		Direct		Indexed (No Offset)		Indexed (8-Bit Offset)			H	I	N	Z	C					
		OP	#	OP	#	OP	#	OP	#	OP	#											
Increment	INC	4C	1	2	5C	1	2	3C	2	5	7C	1	5	8C	2	6	A+1→A or X+1→X or M+1→M	●	●	^	^	●
Decrement	DEC	4A	1	2	5A	1	2	3A	2	5	7A	1	5	8A	2	6	A-1→A or X-1→X or M-1→M	●	●	^	^	●
Clear	CLR	4F	1	2	5F	1	2	3F	2	5	7F	1	5	8F	2	6	00→A or 00→X or 00→M	●	●	0	1	●
Complement	COM	43	1	2	53	1	2	33	2	5	73	1	5	83	2	6	\bar{A} →A or \bar{X} →X or \bar{M} →M	●	●	^	^	1
Negate (2's Complement)	NEG	40	1	2	50	1	2	30	2	5	70	1	5	80	2	6	00→A→A or 00→X→X or 00→M→M	●	●	^	^	^
Rotate Left Thru Carry	ROL	49	1	2	59	1	2	39	2	5	79	1	5	89	2	6		●	●	^	^	^
Rotate Right Thru Carry	ROR	46	1	2	56	1	2	36	2	5	76	1	5	86	2	6		●	●	^	^	^
Logical Shift Left	LSL	48	1	2	58	1	2	38	2	5	78	1	5	88	2	6		●	●	^	^	^
Logical Shift Right	LSR	44	1	2	54	1	2	34	2	5	74	1	5	84	2	6		●	●	0	^	^
Arithmetic Shift Right	ASR	47	1	2	57	1	2	37	2	5	77	1	5	87	2	6		●	●	^	^	^
Arithmetic Shift Left	ASL	48	1	2	58	1	2	38	2	5	78	1	5	88	2	6	Equal to LSL	●	●	^	^	^
Test for Negative or Zero	TST	4D	1	2	5D	1	2	3D	2	4	7D	1	4	8D	2	5	A-00 or X-00 or M-00	●	●	^	^	●

Symbols: Op = Operation
 # = Number of bytes
 ~ = Number of cycles

Table 7 Branch Instructions

Operations	Mnemonic	Addressing Modes			Branch Test	Condition Code				
		Relative				H	I	N	Z	C
		OP	#	~						
Branch Always	BRA	20	2	3	None	●	●	●	●	●
Branch Never	BRN	21	2	3	None	●	●	●	●	●
Branch IF Higher	BHI	22	2	3	C+Z=0	●	●	●	●	●
Branch IF Lower or Same	BLS	23	2	3	C+Z=1	●	●	●	●	●
Branch IF Carry Clear	BCC	24	2	3	C=0	●	●	●	●	●
(Branch IF Higher or Same)	(BHS)	24	2	3	C=0	●	●	●	●	●
Branch IF Carry Set	BCS	25	2	3	C=1	●	●	●	●	●
(Branch IF Lower)	(BLO)	25	2	3	C=1	●	●	●	●	●
Branch IF Not Equal	BNE	26	2	3	Z=0	●	●	●	●	●
Branch IF Equal	BEQ	27	2	3	Z=1	●	●	●	●	●
Branch IF Half Carry Clear	BHCC	28	2	3	H=0	●	●	●	●	●
Branch IF Half Carry Set	BHCS	29	2	3	H=1	●	●	●	●	●
Branch IF Plus	BPL	2A	2	3	N=0	●	●	●	●	●
Branch IF Minus	BMI	2B	2	3	N=1	●	●	●	●	●
Branch IF Interrupt Mask Bit is Clear	BMC	2C	2	3	I=0	●	●	●	●	●
Branch IF Interrupt Mask Bit is Set	BMS	2D	2	3	I=1	●	●	●	●	●
Branch IF Interrupt Line is Low	BIL	2E	2	3	INT=0	●	●	●	●	●
Branch IF Interrupt Line is High	BIH	2F	2	3	INT=1	●	●	●	●	●
Branch to Subroutine	BSR	AD	2	5	—	●	●	●	●	●

Symbols: Op = Operation
 # = Number of bytes
 ~ = Number of cycles

Table 8 Bit Manipulation Instructions

Operations	Mnemonic	Addressing Modes						Boolean/ Arithmetic Operation	Branch Test	Condition Code				
		Bit Set/ Clear			Bit Test and Branch					H	I	N	Z	C
		OP	#	~	OP	#	~							
Branch IF Bit n is set	BRSET n(n=0...7)	—	—	—	2·n	3	5	—	Mn=1	●	●	●	●	^
Branch IF Bit n is clear	BRCLR n(n=0...7)	—	—	—	01+2·n	3	5	—	Mn=0	●	●	●	●	^
Set Bit n	BSET n(n=0...7)	10+2·n	2	5	—	—	—	1→Mn	—	●	●	●	●	●
Clear Bit n	BCLR n(n=0...7)	11+2·n	2	5	—	—	—	0→Mn	—	●	●	●	●	●

Symbols: Op = Operation
 # = Number of bytes
 ~ = Number of cycles

Table 9 Control Instructions

Operations	Mnemonic	Addressing Modes			Boolean Operation	Condition Code				
		Implied				H	I	N	Z	C
		OP	#	~						
Transfer A to X	TAX	97	1	2	A→X	●	●	●	●	●
Transfer X to A	TXA	9F	1	2	X→A	●	●	●	●	●
Set Carry Bit	SEC	99	1	1	1→C	●	●	●	●	1
Clear Carry Bit	CLC	98	1	1	0→C	●	●	●	●	0
Set Interrupt Mask Bit	SEI	9B	1	2	1→I	●	1	●	●	●
Clear Interrupt Mask Bit	CLI	9A	1	2	0→I	●	0	●	●	●
Software Interrupt	SWI	83	1	10		●	1	●	●	●
Return from Subroutine	RTS	81	1	5		●	●	●	●	●
Return from Interrupt	RTI	80	1	8		?	?	?	?	?
Reset Stack Pointer	RSP	9C	1	2	\$FF→SP	●	●	●	●	●
No-Operation	NOP	9D	1	1	Advance Prog. Cntr. Only	●	●	●	●	●
Decimal Adjust A	DAA	8D	1	2	Converts binary add of BCD characters into BCD format	●	●	^	^	^*
Stop	STOP	8E	1	4		●	●	●	●	●
Wait	WAIT	8F	1	4		●	●	●	●	●

Symbols: Op = Operation
 # = Number of bytes
 ~ = Number of cycles
 * Are BCD characters of upper byte 10 or more? (They are not cleared if set in advance.)

Table 10 Instruction Set (in Alphabetical Order)

Mnemonic	Addressing Modes									Condition Code					
	Implied	Immediate	Direct	Extended	Relative	Indexed (No Offset)	Indexed (8-Bit)	Indexed (16-Bit)	Bit Set/Clear	Bit Test & Branch	H	I	N	Z	C
ADC		x	x	x		x	x	x			^	●	^	^	^
ADD		x	x	x		x	x	x			^	●	^	^	^
AND		x	x	x		x	x	x			●	●	^	^	●
ASL	x		x			x	x				●	●	^	^	^
ASR	x		x			x	x				●	●	^	^	^
BCC					x						●	●	●	●	●
BCLR									x		●	●	●	●	●
BCS					x						●	●	●	●	●
BEQ					x						●	●	●	●	●
BHCC					x						●	●	●	●	●
BHCS					x						●	●	●	●	●
BHI					x						●	●	●	●	●
(BHS)					x						●	●	●	●	●
BIH					x						●	●	●	●	●
BIL					x						●	●	●	●	●
BIT		x	x	x		x	x	x			●	●	^	^	●
(BLO)					x						●	●	●	●	●
BLS					x						●	●	●	●	●
BMC					x						●	●	●	●	●
BMI					x						●	●	●	●	●
BMS					x						●	●	●	●	●
BNE					x						●	●	●	●	●
BPL					x						●	●	●	●	●
BRA					x						●	●	●	●	●

Condition Code Symbols:
 H Half Carry (From Bit 3)
 I Interrupt Mask
 N Negative (Sign Bit)
 Z Zero
 C Carry/Borrow
 ^ Test and Set if True, Cleared Otherwise
 ● Not Affected
 ? Load CC Register From Stack

(to be continued)

Table 10 Instruction Set (in Alphabetical Order)

Mnemonic	Addressing Modes									Condition Code					
	Implied	Immediate	Direct	Extended	Relative	Indexed (No Offset)	Indexed (8-Bit)	Indexed (16-Bit)	Bit Set/ Clear	Bit Test & Branch	H	I	N	Z	C
BRN					X						●	●	●	●	●
BRCLR										X	●	●	●	●	^
BRSET										X	●	●	●	●	^
BSET									X		●	●	●	●	●
BSR					X						●	●	●	●	●
CLC	X										●	●	●	●	0
CLI	X										●	0	●	●	●
CLR	X		X			X	X				●	●	0	1	●
CMP		X	X	X		X	X	X			●	●	^	^	^
COM	X		X			X	X				●	●	^	^	1
CPX		X	X	X		X	X	X			●	●	^	^	^
DAA	X										●	●	^	^	^
DEC	X		X			X	X				●	●	^	^	●
EOR		X	X	X		X	X	X			●	●	^	^	●
INC	X		X			X	X				●	●	^	^	●
JMP			X	X		X	X	X			●	●	●	●	●
JSR			X	X		X	X	X			●	●	●	●	●
LDA		X	X	X		X	X	X			●	●	^	^	●
LDX		X	X	X		X	X	X			●	●	^	^	●
LSL	X		X			X	X				●	●	^	^	^
LSR	X		X			X	X				●	●	0	^	^
NEG	X		X			X	X				●	●	^	^	^
NOP	X										●	●	●	●	●
ORA		X	X	X		X	X	X			●	●	^	^	●
ROL	X		X			X	X				●	●	^	^	^
ROR	X		X			X	X				●	●	^	^	^
RSP	X										●	●	●	●	●
RTI	X										?	?	?	?	?
RTS	X										●	●	●	●	●
SBC		X	X	X		X	X	X			●	●	^	^	^
SEC	X										●	●	●	●	1
SEI	X										●	1	●	●	●
STA			X	X		X	X	X			●	●	^	^	●
STOP	X										●	●	●	●	●
STX			X	X		X	X	X			●	●	^	^	●
SUB		X	X	X		X	X	X			●	●	^	^	^
SWI	X										●	1	●	●	●
TAX	X										●	●	●	●	●
TST	X		X			X	X				●	●	^	^	●
TXA	X										●	●	●	●	●
WAIT	X										●	●	●	●	●

Condition Code Symbols:

- | | | | |
|---|-------------------------|---|---|
| H | Half Carry (From Bit 3) | C | Carry/Borrow |
| I | Interrupt Mask | ^ | Test and Set if True, Cleared Otherwise |
| N | Negative (Sign Bit) | ● | Not Affected |
| Z | Zero | ? | Load CC Register From Stack |

Table 11 Operation Code Map

	Bit Manipulation		Branch	Read/Modify/Write					Control		Register/Memory						← HIGH LOW	
	Test & Branch	Set/Clear	Rel	DIR	A	X	,X1	,X0	IMP	IMP	IMM	DIR	EXT	,X2	,X1	,X0		
	0	1	2	3	4	5	6	7	8	9	A	B	C	D	E	F		
0	BRSET0	BSET0	BRA	NEG					RTI*	—	SUB						0	
1	BRCLR0	BCLR0	BRN	—					RTS*	—	CMP						1	
2	BRSET1	BSET1	BHI	—					—	—	SBC						2	
3	BRCLR1	BCLR1	BLS	COM					SWI*	—	CPX						3	
4	BRSET2	BSET2	BCC	LSR					—	—	AND						4	
5	BRCLR2	BCLR2	BCS	—					—	—	BIT						5	
6	BRSET3	BSET3	BNE	ROR					—	—	LDA						6	
7	BRCLR3	BCLR3	BEQ	ASR					—	TAX*	—	STA				STA(+1)	7	
8	BRSET4	BSET4	BHCC	LSL/ASL					—	CLC	EOR						8	
9	BRCLR4	BCLR4	BHCS	ROL					—	SEC	ADC						9	
A	BRSET5	BSET5	BPL	DEC					—	CLI*	ORA						A	
B	BRCLR5	BCLR5	BMI	—					—	SEI*	ADD						B	
C	BRSET6	BSET6	BMC	INC					—	RSP*	—	JMP(-1)						C
D	BRCLR6	BCLR6	BMS	TST(-1)	TST	TST(-1)		DAA*	NOP	BSR*	JSR(+2)	JSR(+1)	JSR(+2)		D			
E	BRSET7	BSET7	BIL	—					STOP*	—	LDX						E	
F	BRCLR7	BCLR7	BIH	CLR					WAIT*	TXA*	—	STX				STX(+1)	F	
	3/5	2/5	2/3	2/5	1/2	1/2	2/6	1/5	1/*	1/1	2/2	2/3	3/4	3/5	2/4	1/3		

- (NOTES) 1. “—” is an undefined operation code.
 2. The lowermost numbers in each column represent a byte count and the number of cycles required (byte count/number of cycles). The number of cycles for the mnemonics asterisked (*) is as follows:
- | | | | |
|------|----|-----|---|
| RTI | 8 | TAX | 2 |
| RTS | 5 | RSP | 2 |
| SWI | 10 | TXA | 2 |
| DAA | 2 | BSR | 5 |
| STOP | 4 | CLI | 2 |
| WAIT | 4 | SEI | 2 |
3. The parenthesized numbers must be added to the cycle count of the particular instruction.

• **Additional Instructions**

The following new instructions are used on the HD6305Y2:

DAA Converts the contents of the accumulator into BCD code.

WAIT Causes the MPU to enter the wait mode. For this mode, see the topic, Wait Mode.

STOP Causes the MPU to enter the stop mode. For this mode, see the topic, Stop Mode.

■ **OPERATION AT EACH INSTRUCTION CYCLE**

The HD6305Y2 employs a mechanism of the pipeline control for the instruction fetch and the subsequent instruction fetch is performed during the current instruction being executed.

Table 12 provides the information about the relationship among each data on the Address Bus, Data Bus and R/W status in cycle-by-cycle basis during the execution of each instruction.

Table 12 Cycle-by-Cycle Operation

Address Mode & Instructions	Cycles	Cycle #	Address Bus	R/W	Data Bus
IMMEDIATE					
ADC, ADD, AND, BIT, CMP, CPX, EOR, LDA, LDX, ORA, SBC, SUB	2	1	Op Code Address +1	1	Operand Data
		2	Op Code Address +2	1	Next Op Code
DIRECT					
ADC, ADD, AND, BIT, CMP, CPX, EOR, LDA, LDX, ORA, SBC, SUB	3	1	Op Code Address +1	1	Address of Operand
		2	Address of Operand	1	Operand Data
		3	Op Code Address +2	1	Next Op Code

(to be continued)

Address Mode & Instructions	Cycles	Cycle #	Address Bus	R/W	Data Bus
STA, STX	3	1	Op Code Address +1	1	Address of Operand
		2	Address of Operand	0	(Data from Acc. Data from Ix.
		3	Op Code Address +1	1	Next Op Code
JMP	2	1	Op Code Address +1	1	Jump Address
		2	Jump Address	1	Next Op Code
JSR	5	1	Op Code Address +1	1	Jump Address (LSB)
		2	1FFF	1	Irrelevant Data
		3	Stack Pointer	0	Return Address (LSB)
		4	Stack Pointer -1	0	Return Address (MSB)
		5	Jump Address	1	First Subroutine Op Code
ASR, CLR, COM, DEC, INC, LSL, LSR, NEG, ROL, ROR	5	1	Op Code Address +1	1	Address of Operand
		2	Address of Operand	1	Operand Data
		3	1FFF	1	Irrelevant Data
		4	Address of Operand	0	New Operand Data
		5	Op Code Address +2	1	Next Op Code
TST	4	1	Op Code Address +1	1	Address of Operand
		2	Address of Operand	1	Operand Data
		3	1FFF	1	Irrelevant Data
		4	Op Code Address +2	1	Next Op Code
EXTENDED					
ADC, ADD, AND, BIT, CMP, CPX, EOR, LDA, LDX, ORA, SBC, SUB	4	1	Op Code Address +1	1	Address of Operand (MSB)
		2	Op Code Address +2	1	Address of Operand (LSB)
		3	Address of Operand	1	Operand Data
		4	Op Code Address +3	1	Next Op Code
STA, STX	4	1	Op Code Address +1	1	Address of Operand (MSB)
		2	Op Code Address +2	1	Address of Operand (LSB)
		3	Address of Operand	0	(Data from Acc. Data from Ix.
		4	Op Code Address +3	1	Next Op Code
JMP	3	1	Op Code Address +1	1	Jump Address (MSB)
		2	Op Code Address +2	1	Jump Address (LSB)
		3	Jump Address	1	Next Op Code
JSR	6	1	Op Code Address +1	1	Jump Address (MSB)
		2	Op Code Address +2	1	Jump Address (LSB)
		3	1FFF	1	Irrelevant Data
		4	Stack Pointer	0	Return Address (LSB)
		5	Stack Pointer -1	0	Return Address (MSB)
		6	Jump Address	1	First Subroutine Op Code
INDEXED (No offset)					
ADC, ADD, AND, BIT, CMP, CPX, EOR, LDA, LDX, ORA, SBC, SUB	3	1	Op Code Address +1	1	Next Op Code
		2	Ix	1	Operand Data
		3	Op Code Address +1	1	Next Op Code
STA, STX	4	1	Op Code Address +1	1	Next Op Code
		2	1FFF	1	Irrelevant Data
		3	Ix	0	(Data from Acc. Data from Ix.
		4	Op Code Address +1	1	Next Op Code
JMP	2	1	Op Code Address +1	1	Next Op Code
		2	Ix	1	First Op Code of Jump Routine

(to be continued)

Address Mode & Instructions	Cycles	Cycle #	Address Bus	R/W	Data Bus
JSR	5	1	Op Code Address +1	1	Next Op Code
		2	1FFF	1	Irrelevant Data
		3	Stack Pointer	0	Return Address (LSB)
		4	Stack Pointer -1	0	Return Address (MSB)
		5	Ix	1	First Subroutine Op Code
ASR, CLR, COM, DEC, INC, LSL, LSR, NEG, ROL, ROR	5	1	Op Code Address +1	1	Next Op Code
		2	Ix	1	Operand Data
		3	1FFF	1	Irrelevant Data
		4	Ix	0	New Operand Data
		5	Op Code Address +1	1	Next Op Code
TST	4	1	Op Code Address +1	1	Next Op Code
		2	Ix	1	Operand Data
		3	1FFF	1	Irrelevant Data
		4	Op Code Address +1	1	Next Op Code
INDEXED (8-bit offset)					
ADC, ADD, AND, BIT, CMP, CPX, EOR, LDA, LDX, ORA, SBC, SUB	4	1	Op Code Address +1	1	Offset
		2	1FFF	1	Irrelevant Data
		3	Ix + Offset	1	Operand Data
		4	Op Code Address +2	1	Next Op Code
STA, STX	4	1	Op Code Address +1	1	Offset
		2	1FFF	1	Irrelevant Data
		3	Ix + Offset	0	(Data from Acc. Data from Ix.
		4	Op Code Address +2	1	Next Op Code
JMP	3	1	Op Code Address +1	1	Offset
		2	1FFF	1	Irrelevant Data
		3	Ix + Offset	1	First Op Code of Jump Routine
JSR	5	1	Op Code Address +1	1	Offset
		2	1FFF	1	Irrelevant Data
		3	Stack Pointer	0	Return Address (LSB)
		4	Stack Pointer -1	0	Return Address (MSB)
		5	Ix + Offset	1	First Subroutine Op Code
ASR, CLR, COM, DEC, INC, LSL, LSR, NEG, ROL, ROR	6	1	Op Code Address +1	1	Offset
		2	1FFF	1	Irrelevant Data
		3	Ix + Offset	1	Operand Data
		4	1FFF	1	Irrelevant Data
		5	Ix + Offset	0	New Operand Data
		6	Op Code Address +1	1	Next Op Code
TST	5	1	Op Code Address +1	1	Offset
		2	1FFF	1	Irrelevant Data
		3	Ix + Offset	1	Operand Data
		4	1FFF	1	Irrelevant Data
		5	Op Code Address +2	1	Next Op Code
INDEXED (16-bit offset)					
ADC, ADD, AND, BIT, CMP, CPX, EOR, LDA, LDX, ORA, SBC, SUB	5	1	Op Code Address +1	1	Offset (MSB)
		2	Op Code Address +2	1	Offset (LSB)
		3	1FFF	1	Irrelevant Data
		4	Ix + Offset	1	Operand Data
		5	Op Code Address +1	1	Next Op Code

(to be continued)

Address Mode & Instructions	Cycles	Cycle #	Address Bus	R/W	Data Bus
STA, STX	5	1	Op Code Address +1	1	Offset (MSB)
		2	Op Code Address +2	1	Offset (LSB)
		3	1FFF	1	Irrelevant Data
		4	Ix + Offset	0	(Data from Acc. Data from Ix.
		5	Op Code Address +3	1	Next Op Code
JMP	4	1	Op Code Address +1	1	Offset (MSB)
		2	Op Code Address +2	1	Offset (LSB)
		3	1FFF	1	Irrelevant Data
		4	Ix + Offset	1	First Op Code of Jump Routine
JSR	6	1	Op Code Address +1	1	Offset (MSB)
		2	Op Code Address +2	1	Offset (LSB)
		3	1FFF	1	Irrelevant Data
		4	Stack Pointer	0	Return Address (LSB)
		5	Stack Pointer -1	0	Return Address (MSB)
		6	Ix + Offset	1	First Subroutine Op Code
IMPLIED					
ASR, CLR, COM, DEC, INC, LSL, LSR, NEG, ROL, ROR, TST	2	1	Op Code Address +1	1	Next Op Code
		2	Op Code Address +1	1	Next Op Code
CLC, NOP, SEC	1	1	Op Code Address +1	1	Next Op Code
RSP, TAX, TXA	2	1	Op Code Address +1	1	Next Op Code
		2	Op Code Address +1	1	Next Op Code
CLI, SEI	2	1	Op Code Address +1	1	Next Op Code
		2	1FFF	1	Irrelevant Data
DAA	2	1	Op Code Address +1	1	Next Op Code
		2	Op Code Address +1	1	Next Op Code
STOP, WAIT	4	1	Op Code Address +1	1	Next Op Code
		2	1FFF	1	Irrelevant Data
		3	1FFF	1	Irrelevant Data
		4	Op Code Address +1	1	Next Op Code
RTI	8	1	Op Code Address +1	1	Next Op Code
		2	1FFF	1	Irrelevant Data
		3	Stack Pointer	1	CC
		4	Stack Pointer +1	1	Acc.
		5	Stack Pointer +2	1	Ix.
		6	Stack Pointer +3	1	Return Address (MSB)
		7	Stack Pointer +4	1	Return Address (LSB)
		8	Return Address	1	First Op Code of Return Routine
RTS	5	1	Op Code Address +1	1	Next Op Code
		2	1FFF	1	Irrelevant Data
		3	Stack Pointer	1	Return Address (MSB)
		4	Stack Pointer +1	1	Return Address (LSB)
		5	Return Address	1	First Op Code of Return Routine
SWI	10	1	Op Code Address +1	1	Next Op Code
		2	1FFF	1	Irrelevant Data
		3	Stack Pointer	0	Return Address (LSB)
		4	Stack Pointer -1	0	Return Address (MSB)
		5	Stack Pointer -2	0	Ix.
		6	Stack Pointer -3	0	Acc.
		7	Stack Pointer -4	0	CC
		8	Vector Address 1FFC	1	Address of SWI Routine (MSB)
		9	Vector Address 1FFD	1	Address of SWI Routine (LSB)
		10	Address of SWI Routine	1	First Op Code of SWI Routine

(to be continued)

Address Mode & Instructions	Cycles	Cycle #	Address Bus	R/W	Data Bus
RELATIVE					
BCC, BCS, BEQ, BHCC, BHCS, BHI, BIH, BIL, BLS, BMC, BMI, BMS, BNE, BPL, BRA, BRN	3	1	Op Code Address +1	1	Next Op Code
		2	1FFF	1	Irrelevant Data
		3	(Branch AddressTest = "1" Op Code Address +1 Test = "0"	1	(First Op Code of Branch Routine Next Op Code
BSR	5	1	Op Code Address +1	1	Offset
		2	1FFF	1	Irrelevant Data
		3	Stack Pointer	0	Return Address (LSB)
		4	Stack Pointer-1	0	Return Address (MSB)
		5	Branch Address	1	First Op Code of Subroutine
BIT TEST AND BRANCH					
BRCLR, BRSET	5	1	Op Code Address +1	1	Address of Operand
		2	Address of Operand	1	Operand Data
		3	Op Code Address +2	1	Offset
		4	1FFF	1	Irrelevant Data
		5	(Branch AddressTest = "1" Op Code Address +3Test = "0"	1	(First Op Code of Branch Address Next Op Code
BIT SET/CLEAR					
BCLR, BSET	5	1	Op Code Address +1	1	Address of Operand
		2	Address of Operand	1	Operand Data
		3	1FFF	1	Irrelevant Data
		4	Address of Operand	0	New Operand Data
		5	Op Code Address +1	1	Next Op Code

HD6800, HD68A00, HD68B00

MPU (Micro Processing Unit)

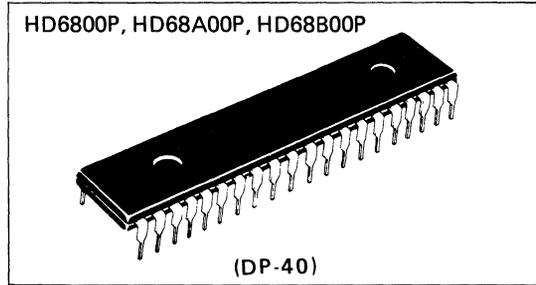
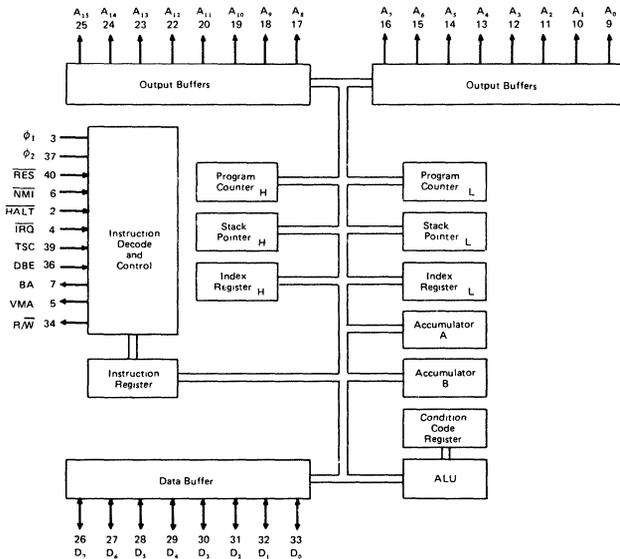
The HD6800 is a monolithic 8-bit microprocessor forming the central control function for Hitachi's HMCS6800 family. Compatible with TTL, the HD6800 as with all HMCS6800 system parts, requires only one 5V power supply, and no external TTL devices for bus interface. The HD68A00 and HD68B00 are high speed versions.

The HD6800 is capable of addressing 65k bytes of memory with its 16-bit address lines. The 8-bit data bus is bi-directional as well as 3-state, making direct memory addressing and multiprocessing applications realizable.

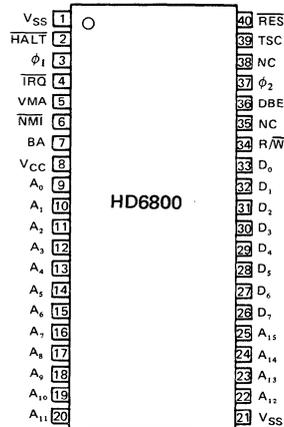
■ FEATURES

- Versatile 72 Instruction – Variable Length (1~3 Byte)
- Seven Addressing Modes – Direct, Relative, Immediate, Indexed, Extended, Implied and Accumulator
- Variable Length Stack
- Vectored Restart
- Maskable Interrupt
- Separate Non-Maskable Interrupt – Internal Registers Saved in Stack
- Six Internal Registers – Two Accumulators, Index Register, Program Counter, Stack Pointer and Condition Code Register
- Direct Memory Accessing (DMA) and Multiple Processor Capability
- Clock Rates as High as 2.0 MHz (HD6800 ... 1 MHz, HD68A00 ... 1.5 MHz, HD68B00 ... 2.0 MHz)
- Halt and Single Instruction Execution Capability
- Compatible with MC6800, MC68A00 and MC68B00

■ BLOCK DIAGRAM



■ PIN ARRANGEMENT



(Top View)

■ ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Value	Unit
Supply Voltage	V_{CC}^*	-0.3 ~ +7.0	V
Input Voltage	V_{in}^*	-0.3 ~ +7.0	V
Operating Temperature	T_{opr}	-20 ~ +75	°C
Storage Temperature	T_{stg}	-55 ~ +150	°C

* With respect to V_{SS} (SYSTEM GND)

(NOTE) Permanent LSI damage may occur if maximum rating are exceeded. Normal operation should be under recommended operating conditions. If these conditions are exceeded, it could affect reliability of LSI.

■ RECOMMENDED OPERATING CONDITION

Item	Symbol	min	typ	max	Unit
Supply Voltage	V_{CC}^*	4.75	5.0	5.25	V
Input Voltage	V_{IL}^*	-0.3	-	0.8	V
	V_{IH}^*	2.0	-	V_{CC}	V
Operating Temperature	T_{opr}	-20	25	75	°C

* With respect to V_{SS} (SYSTEM GND)

■ ELECTRICAL CHARACTERISTICS

● DC CHARACTERISTICS ($V_{CC} = 5V \pm 5\%$, $V_{SS} = 0V$, $T_a = -20 \sim +75^\circ C$, unless otherwise noted.)

Item	Symbol	Test Condition	min	typ*	max	Unit	
Input "High" Voltage	Logic**	V_{IH}	2.0	-	V_{CC}	V	
Input "Low" Voltage	Logic**	V_{IL}	-0.3	-	0.8	V	
Clock Input "High" Voltage	ϕ_1, ϕ_2	V_{IHC}	$V_{CC} - 0.6$	-	$V_{CC} + 0.3$	V	
Clock Input "Low" Voltage	ϕ_1, ϕ_2	V_{ILC}	-0.3	-	0.4	V	
Output "High" Voltage	$D_0 \sim D_7$	V_{OH}	$I_{OH} = -205\mu A$	2.4	-	-	V
	$A_0 \sim A_{15}, R/\bar{W}$ VMA		$I_{OH} = -145\mu A$	2.4	-	-	V
	BA		$I_{OH} = -100\mu A$	2.4	-	-	V
Output "Low" Voltage	V_{OL}	$I_{OL} = 1.6mA$	-	-	0.4	V	
Input Leakage Current	Logic***	I_{in}	$V_{in} = 0 \sim 5.25V$, All other pins are connected to GND	-2.5	-	2.5	μA
	ϕ_1, ϕ_2			-100	-	100	μA
Three-State (Off-state) Input Current	$D_0 \sim D_7$	I_{TSI}	$V_{in} = 0.4 \sim 2.4V$	-10	-	10	μA
	$A_0 \sim A_{15}, R/\bar{W}$			-100	-	100	μA
Power Dissipation	P_D		-	0.5	1.0	W	
Input Capacitance	Logic***	C_{in}	$V_{in} = 0V, T_a = 25^\circ C$, $f = 1 MHz$	-	6.5	10	pF
	$D_0 \sim D_7$			-	10	12.5	pF
	ϕ_1			-	25	35	pF
	ϕ_2			-	45	70	pF
Output Capacitance	$A_0 \sim A_{15}, R/\bar{W}$ VMA, BA	C_{out}	$V_{in} = 0V, T_a = 25^\circ C$, $f = 1 MHz$	-	-	12	pF

* $T_a = 25^\circ C, V_{CC} = 5V$

** All inputs except ϕ_1 and ϕ_2

*** All inputs except ϕ_1, ϕ_2 and $D_0 \sim D_7$

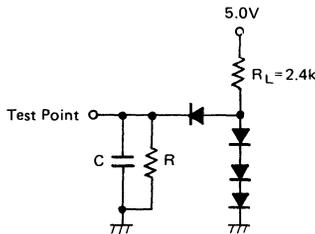
● AC CHARACTERISTICS (V_{CC} = 5V ± 5%, V_{SS} = 0V, T_a = -20~+75°C, unless otherwise noted.)

1. TIMING CHARACTERISTICS OF CLOCK PULSE ϕ_1 and ϕ_2

Item	Symbol	Test Condition	HD6800			HD68A00			HD68B00			Unit
			min	typ	max	min	typ	max	min	typ	max	
Frequency of Operation	f		0.1	—	1.0	0.1	—	1.5	0.1	—	2.0	MHz
Cycle Time	t _{cyc}	Fig. 10	1.000	—	10	0.666	—	10	0.500	—	10	μs
Clock Pulse Width	ϕ_1, ϕ_2	PW _{CH1} , PW _{CH2}	400	—	4,500	230	—	4,500	180	—	4,500	ns
Rise and Fall Times	ϕ_1, ϕ_2	t _r , t _f	—	—	100	—	—	100	—	—	100	ns
Delay Time (Clock Internal)	t _d	Fig. 10	0	—	4,500	0	—	4,500	0	—	4,500	ns
Clock "High" Level Time	t _{UT}	Fig. 10	900	—	—	600	—	—	440	—	—	ns

2. READ/WRITE CHARACTERISTICS

Item	Symbol	Test Condition	HD6800			HD68A00			HD68B00			Unit
			min	typ	max	min	typ	max	min	typ	max	
Address Delay Time	C=90pF	t _{AD1}	—	—	270	—	—	180	—	—	150	ns
	C=30pF	t _{AD2}	—	—	250	—	—	165	—	—	135	ns
Data Setup Time (Read)	t _{DSR}	Fig. 11	100	—	—	60	—	—	40	—	—	ns
Peripheral Read Access Time t _{acc} = t _{UT} - (t _{AD} + t _{DSR})	t _{acc}	Fig. 11	—	—	530	—	—	360	—	—	250	ns
Input Data Hold Time	t _H	Fig. 11	10	—	—	10	—	—	10	—	—	ns
Output Data Hold Time	t _H	Fig. 12	20	—	—	20	—	—	20	—	—	ns
Address Hold Time (Address, R/W, VMA)	t _{AH}	Fig. 11, Fig. 12	10	—	—	10	—	—	10	—	—	ns
Enable "High" Time for DBE Input	t _{EH}	Fig. 12	450	—	—	280	—	—	220	—	—	ns
Data Delay Time (Write)	t _{DDW}	Fig. 12	—	—	225	—	—	200	—	—	160	ns
Data Bus Enable Down Time (During ϕ_1 Up Time)	t _{DBE}	Fig. 12	150	—	—	120	—	—	75	—	—	ns
Data Bus Enable Delay Time	t _{DBED}	Fig. 12	300	—	—	250	—	—	180	—	—	ns
Data Bus Enable Rise and Fall Times	t _{DBEr} , t _{DBEf}	Fig. 12	—	—	25	—	—	25	—	—	25	ns
Processor Control Setup Time	t _{PCS}		200	—	—	140	—	—	110	—	—	ns
Processor Control Rise and Fall Times	t _{PCr} , t _{PCf}		—	—	100	—	—	100	—	—	100	ns
Bus Available Delay Time (BA)	t _{BA}		—	—	250	—	—	165	—	—	135	ns
Three-State Delay Time	t _{TSD}		—	—	270	—	—	270	—	—	220	ns



C = 130pF for D₀~D₇,
 = 90pF for A₀~A₁₅, R/W, and VMA
 = 30pF for BA
 R = 11kΩ for D₀~D₇,
 = 16kΩ for A₀~A₁₅, R/W and VMA
 = 24kΩ for BA
 C includes Stray Capacitance.
 All diodes are 1S2074 (E) or equivalent.

Figure 1 Bus Timing Test Load

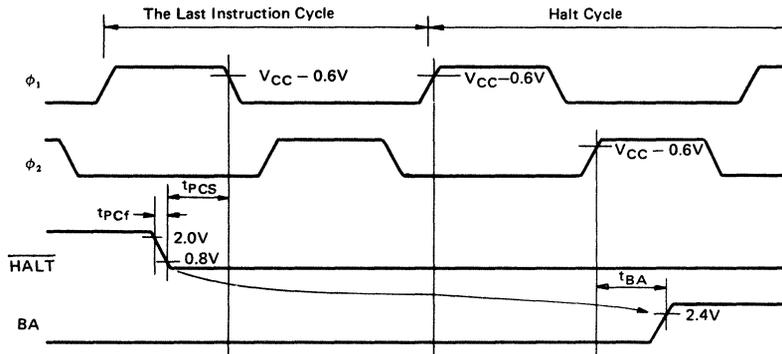


Figure 2 Timing of HALT and BA

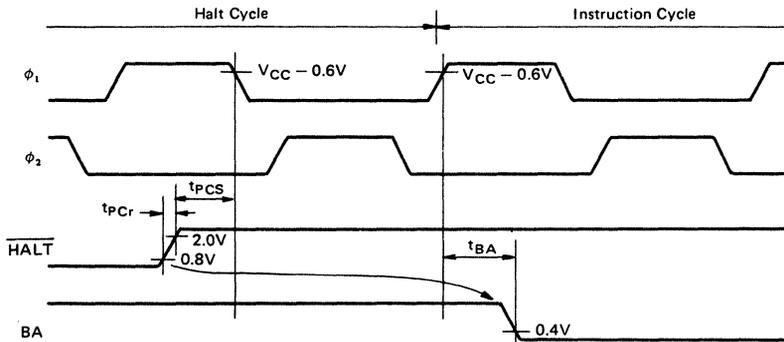


Figure 3 Timing of HALT and BA

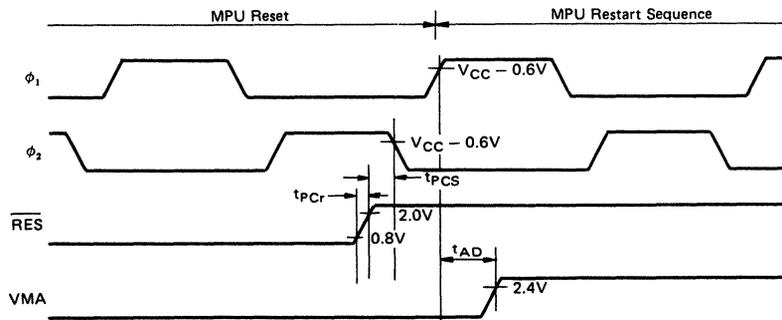


Figure 4 \overline{RES} and MPU Restart Sequence

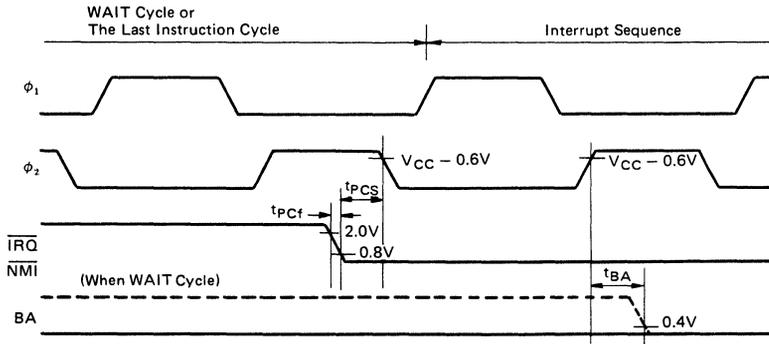


Figure 5 $\overline{\text{IRQ}}$ and $\overline{\text{NMI}}$ Interrupt Timing

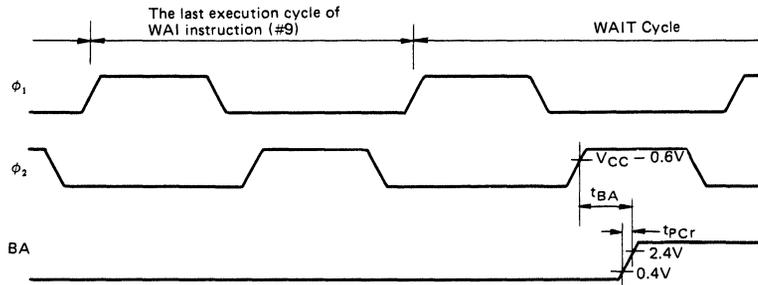


Figure 6 WAIT Instruction and BA Timing

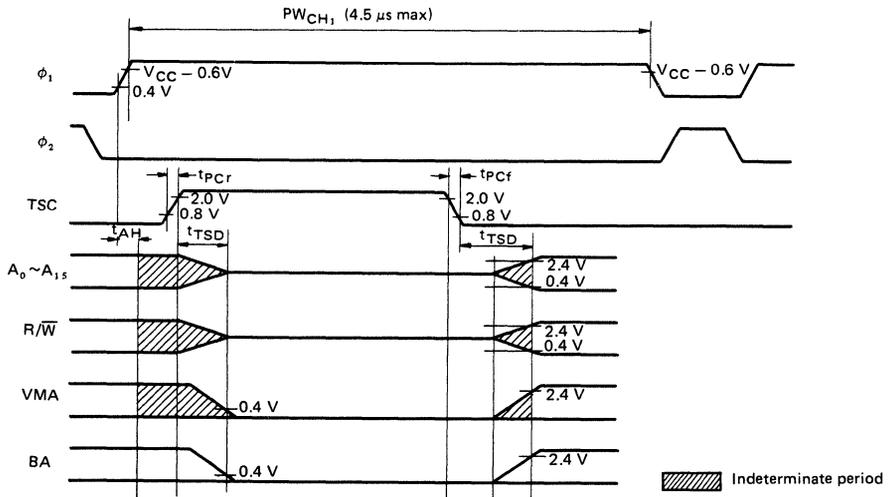


Figure 7 TSC Input and MPU Output

■ MPU REGISTERS

The MPU provides several registers in Fig. 8, which is available for use by the programmer.

Each register is described below.

● Program Counter (PC)

The program counter is a two byte (16-bit) register that points to the current program address.

● Stack Pointer (SP)

The stack pointer is a two byte register that contains the address of the next available location in an external push-down/pop-up stack. This stack is normally a random access Read/Write memory that may have any location (address) that is convenient. In those applications that require storage of information in the stack when power is lost, the stack must be non-volatile.

● Index Register (IX)

The index register is a two byte register that is used to store data or a sixteen bit memory address for the Indexed mode of memory addressing.

● Accumulators (ACCA, ACCB)

The MPU contains two 8-bit accumulators that are used to hold operands and results from an arithmetic logic unit (ALU).

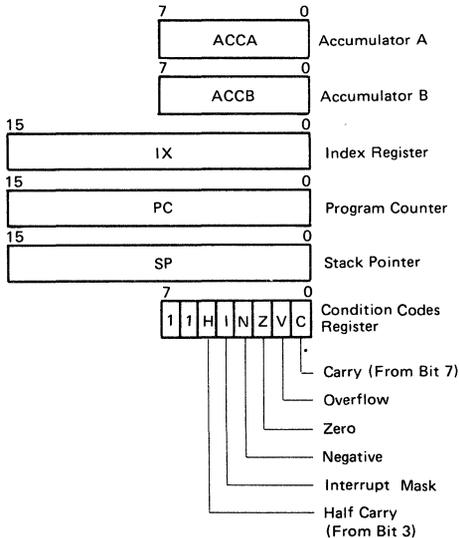


Figure 8 Programming Model of the Microprocessing Unit

● Condition Code Register (CCR)

The condition code register indicates the results of an Arithmetic Logic Unit operation: Negative (N), Zero (Z), Overflow (V), Carry from bit 7 (C), and half carry from bit 3(H). These bits of the Condition Code Register are used as testable conditions for the conditional branch instructions. Bit 4 is the interrupt mask bit (I). The unused bits of the Condition Code Register (b6 and b7) are "1". The detail block diagram of the microprocessing unit is shown in Fig. 9.

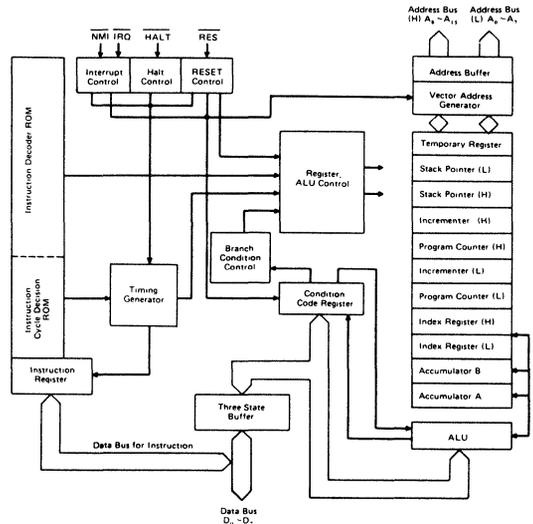


Figure 9 Internal Block Diagram of MPU

■ MPU SIGNAL DESCRIPTION

Proper operations of the MPU requires that certain control and timing signals (Fig. 9) be provided to accomplish specific functions. The functions of pins are explained in this section.

● Clock (ϕ_2, ϕ_1)

Two pins are used to provide the clock signals. A two-phase non-overlapping clock is provided as shown in Fig. 10.

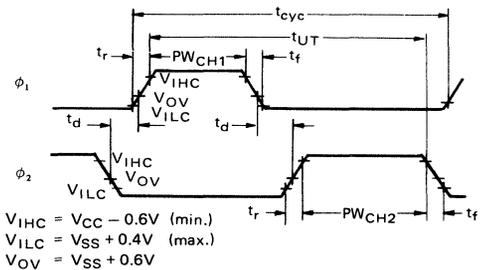


Figure 10 Clock Timing Waveform

● Address Bus ($A_0 \sim A_{15}$)

Sixteen pins are used for the address bus. The outputs are three-state bus drivers capable of driving one standard TTL load and 90pF. When the output is turned off, it is essentially an open circuit. This permits the MPU to be used in DMA applications. Putting TSC in its high state forces the Address bus to go into the three-state mode.

● Data Bus ($D_0 \sim D_7$)

Eight pins are used for the data bus. It is bidirectional, transferring data to and from the memory and peripheral devices. It also has three-state output buffers capable of driving one standard TTL load and 130pF. Data Bus is placed in the three-state mode when DBE is "Low."

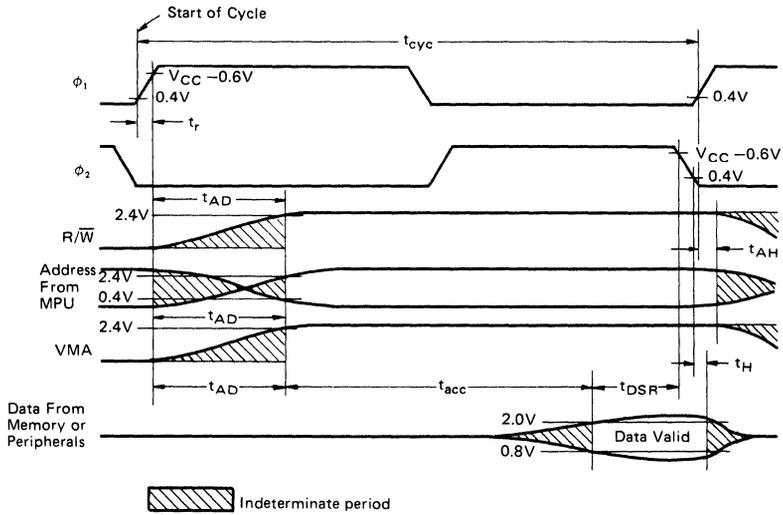


Figure 11 Read from Memory or Peripherals

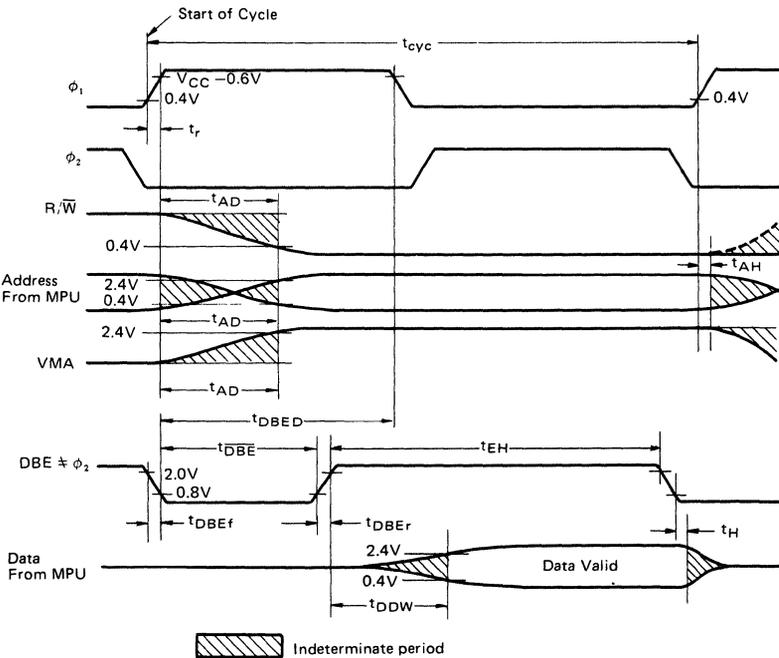


Figure 12 Write to Memory or Peripherals

● **Data Bus Enable (DBE)**

This input is the three-state control signal for the MPU data bus and will enable the bus drivers when in the "High" state; will make the bus driver off when in the "Low" state. This input is TTL compatible; however in normal operation, it would be driven by ϕ_2 clock. During an MPU read cycle, the data bus drivers will be disabled internally. When it is desired that another device control the data bus such as in Direct Memory Access (DMA) applications, DBE should be held "Low."

If additional data setup or hold time is required on an MPU write, the DBE down time can be decreased as shown in Fig. 13 (DBE $\bar{\kappa}$ ϕ_2). The minimum down time for DBE is $t_{\overline{DBE}}$ as shown and must occur within ϕ_1 up time. As for the characteristic values in Fig. 12, refer to the table of electrical characteristics.

● **Bus Available (BA)**

The BA signal will normally be in the "Low" state. When activated, it will go to the "High" state indicating that the microprocessor has stopped and that the address bus is available. This will occur if the HALT line is in the "Low" state or the processor is in the WAIT state as a result of the execution of a WAIT instruction. At such time, all three-state output drivers will go to their off state and other outputs to their normally inactive level. The processor is removed from the WAIT state by the occurrence of a maskable (mask bit I = 0) or nonmaskable interrupt. This output is capable of driving one standard TTL load and 30pF. If TSC is in the "High" state, Bus Available will be "Low".

● **Read/Write (R/W)**

This TTL compatible output signals the peripherals and memory devices whether the MPU is in a Read ("High") or

Write ("Low") state. The normal standby state of this signal is Read ("High"). Three-State Control going "High" will turn R/W to the off (high impedance) state. Also, when the processor is halted, it will be in the off state. This output is capable of driving one standard TTL load and 90pF.

● **Reset (RES)**

The RES input is used to reset and start the MPU from a power down condition resulting from a power failure or initial start-up of the processor. This input can also be used to re-initialize the machine at any time after start-up.

If a "High" level is detected in this input, this will signal the MPU to begin the reset sequence. During the reset sequence, the contents of the last two locations (FFFE, FFFF) in memory will be loaded into the Program Counter to point to the beginning of the reset routine. During the reset routine, the interrupt mask bit is set and must be cleared under program control before the MPU can be interrupted by IRQ. While RES is "Low" (assuming a minimum of 8 clock cycles have occurred) the MPU output signals will be in the following states; VMA = "Low", BA = "Low", Data Bus = high impedance, R/W = "High" (read state), and the Address Bus will contain the reset address FFFE. Fig. 13 illustrates a power up sequence using the Reset control line. After the power supply reaches 4.75V, a minimum of eight clock cycles are required for the processor to stabilize in preparation for restarting. During these eight cycles, VMA will be in an indeterminate state so any devices that are enabled by VMA which could accept a false write during this time (such as a battery-backed RAM) must be disabled until VMA is forced "Low" after eight cycles. RES can go "High" asynchronously with the system clock any time after the eighth cycle.

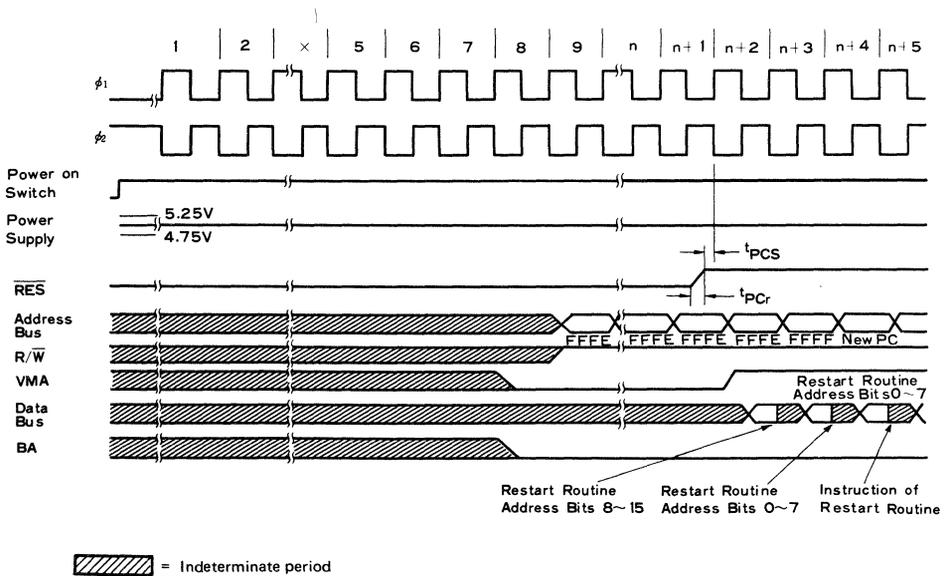


Figure 13 RES Timing

The Reset control line may also be used to reinitialize the MPU system at any time during its operation. This is accomplished by pulsing RES "Low" for the duration of a minimum of three complete ϕ_2 cycles. The RES pulse can be completely asynchronous with the MPU system clock and will be recognized during ϕ_2 if setup time t_{PCS} is met.

● **Interrupt Request (IRQ)**

This level sensitive input requests that an interrupt sequence be generated within the machine. The processor will wait until it completes the current instruction that is being executed before it recognizes the request. If the interrupt mask bit in the Condition Code Register is not set, the machine will begin an interrupt sequence. The Program Counter, Index Register, Accumulators, and Condition Code Register are stored away on the stack.

Next the MPU will respond to the interrupt request by setting the interrupt mask bit "1" so that no further interrupts may occur. At the end of the cycle, a 16-bit address will be loaded that points to a vectoring address which is located in memory locations FFF8 and FFF9. An address loaded at these locations causes the MPU to branch to an interrupt routine in memory. Interrupt timing is shown in Fig. 14.

The HALT line must be in the "High" state for interrupts to be serviced. Interrupts will be latched internally while HALT is "Low". The IRQ has a high impedance pullup device internal to the chip; however a 3k Ω external resistor to V_{CC} should be used for wire-OR and optimum control of interrupts.

● **Non-Maskable Interrupt (NMI) and Wait for Interrupt (WAI)**

The MPU is capable of handling two types of interrupts: maskable (IRQ) as described earlier, and non-maskable (NMI). IRQ is maskable by the interrupt mask in the Condition Code Register while NMI is not maskable. The handling of these interrupts by the MPU is the same except that each has its own vector address. The behavior of the MPU when interrupted is shown in Fig. 14 which details the MPU response to an interrupt while the MPU is executing the control program. The interrupt shown could be either IRQ or NMI and can be asynchronous with respect to ϕ_2 . The interrupt is shown going "Low" at time t_{PCS} in cycle #0 which precedes the first cycle of an instruction (OP code fetch). This instruction is not executed but instead the Program Counter (PC), Index Register (IX), Accumulators (ACCX), and the Condition Code Register (CCR) are pushed onto the stack.

The Interrupt Mask bit is set to prevent further interrupts. The address of the interrupt service routine is then fetched from FFFC, FFFD for an NMI interrupt and from FFF8, FFF9 for an IRQ interrupt. Upon completion of the interrupt service routine, the execution of RTI will pull the PC, IX, ACCX, and CCR off of the stack; the Interrupt Mask bit is restored to its condition prior to interrupts. Fig. 15 is a similar interrupt sequence, except in this case, a WAIT instruction has been executed in preparation for the interrupt. This technique speeds up the MPU's response to the interrupt because the stacking of

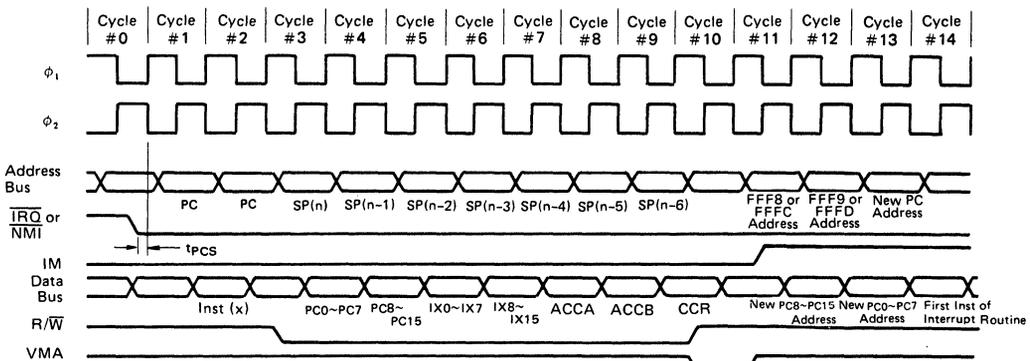
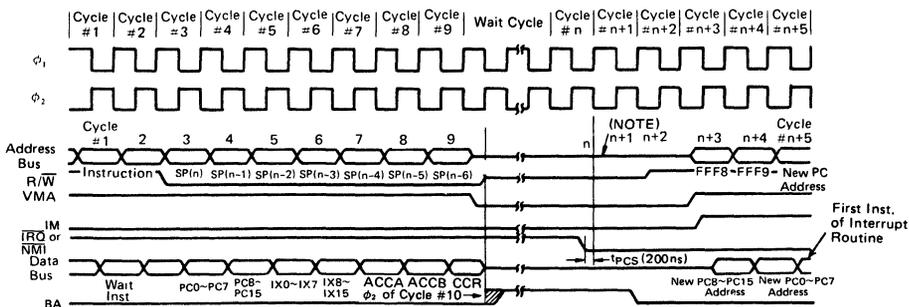


Figure 14 Interrupt Timing



(NOTE) Midrange waveform indicates high impedance state.

Figure 15 WAI Instruction Timing



the PC, IX, ACCX, and the CCR is already done.

While the MPU is waiting for the interrupt, Bus Available will go "High" indicating the following states of the control lines: VMA is "Low", and the Address Bus, R/W and Data Bus are all in the high impedance state. After the interrupt occurs, it is serviced as previously described.

Table 1 Memory Map for Interrupt Vectors

Vector		Description
MS	LS	
FFFE	FFFF	Restart
FFFC	FFFD	Non-maskable Interrupt
FFFA	FFFB	Software Interrupt
FFF8	FFF9	Interrupt Request

Refer to Figure 18 for program flow for Interrupts.

● Three State Control (TSC)

When the Three State Control (TSC) line is "High" level, the Address Bus and the R/W line are placed in a high impedance State. VMA and BA are forced "Low" when TSC = "High" to prevent false reads or writes on any device enabled by VMA. It is necessary to delay program execution while TSC is held "High". This is done by insuring that no transitions of ϕ_1 (or ϕ_2) occur during this period. (Logic levels of the clocks are irrelevant so long as they do not change.)

Since the MPU is a dynamic device, the ϕ_1 clock can be stopped for a maximum time PW_{CH1} without destroying data within the MPU. TSC then can be used in a short Direct Memory Access (DMA) application.

Fig. 16 shows the effect of TSC on the MPU. The Address Bus and R/W line will reach the high impedance state at t_{TSD} (three-state delay), with VMA being forced "Low". In this example, the Data Bus is also in the high impedance state while ϕ_2 is being held "Low" since $DBE = \phi_2$. At this point in time, a DMA transfer could occur on cycles #3 and #4. When TSC is returned "Low," the MPU address and R/W lines return to the bus. Because it is too late in cycle #5 to access memory, this cycle is dead and used for synchronization. Program execution resumes in cycle #6.

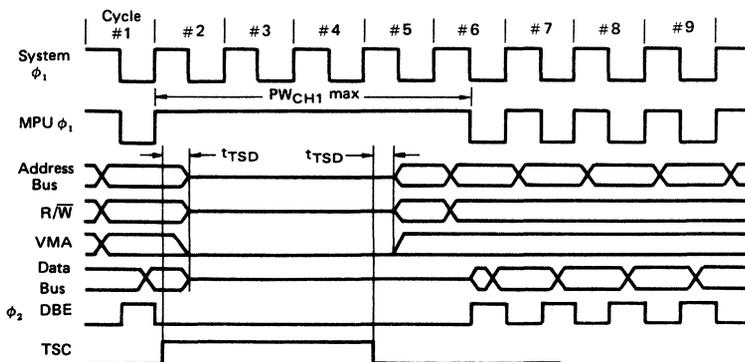


Figure 16 TSC Control Timing

● Valid Memory Address (VMA)

This output indicates to peripheral devices that there is a valid address on the address bus. In normal operation, this signal should be utilized for enabling peripheral interfaces such as the PIA and ACIA. This signal is not three-state. One standard TTL load and 90pF may be directly driven by this active "High" signal.

● Halt (HALT)

When this input is in the "Low" state, all activity in the machine will be halted. This input is level sensitive.

The HALT line provides an input to the MPU to allow control or program execution by an outside source. If HALT is "High", the MPU will execute the instructions; if it is "Low", the MPU will go to a halted or idle mode. A response signal, Bus Available (BA) provides an indication of the current MPU status. When BA is "Low", the MPU is in the process of executing the control program; if BA is "High", the MPU has halted and all internal activity has stopped.

When BA is "High", the Address Bus, Data Bus, and R/W line will be in a high impedance state, effectively removing the MPU from the system bus. VMA is forced "Low" so that the floating system bus will not activate any device on the bus that is enabled by VMA.

While the MPU is halted, all program activity is stopped, and if either an NMI or IRQ interrupt occurs, it will be latched into the MPU and acted on as soon as the MPU is taken out of the halted mode. If a RES command occurs while the MPU is halted, the following states occur: VMA = "Low", BA = "Low", Data Bus = high impedance, R/W = "High" (read state), and the Address Bus will contain address FFFE as long as RES is "Low". As soon as the RES line goes "High", the MPU will go to locations FFFE and FFFF for the address of the reset routine.

Fig. 18 shows the timing relationships involved when halting the MPU. The instruction illustrated is a one byte, 2 cycle instruction such as CLRA. When HALT goes "Low", the MPU will halt after completing execution of the current instruction. The transition of HALT must occur t_{PCS} before the trailing edge of ϕ_1 of the last cycle of an instruction (point A of Fig. 18). HALT must not go "Low" any time later than the minimum t_{PCS} specified.

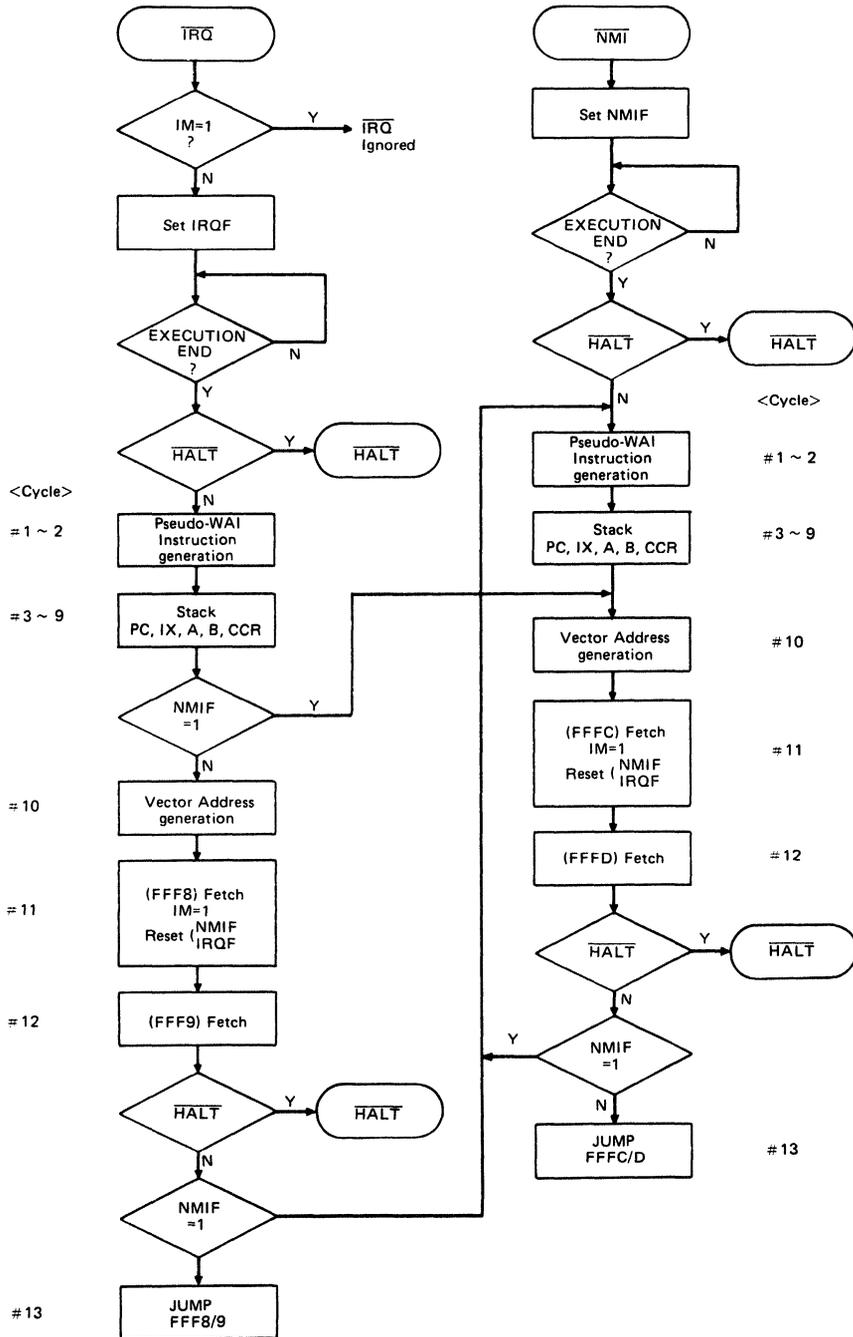
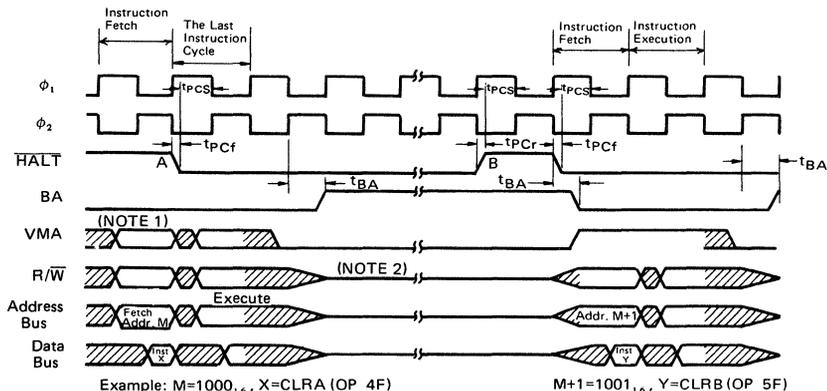


Figure 17 MPU Interrupt Flow Chart



(NOTE) 1. Oblique lines indicate indeterminate range of data.
 2. Midrange waveform indicates high impedance state.

Figure 18 HALT and Single Instruction Execution for System Debug

Table 2 Operation States of MPU and Signal Outputs (Except the Execution of Instruction)

Signals	Halt state	Reset state	Halt and Reset state	WAI state	TSC state
BA	"H"	"L"	"L"	"H"	"L"
VMA	"L"	"L"	"L"	"L"	"L"
R/W	"T"	"H"	"H"	"T"	"T"
A ₀ ~ A ₁₅	"T"	(FFFE) ₁₆	(FFFE) ₁₆	"T"	"T"
D ₀ ~ D ₇	"T"	"T"	"T"	"T"	-

"T" indicates high impedance state.

The fetch of the OP code by the MPU is the first cycle of the instruction. If HALT had not been "Low" at Point A but went "Low" during ϕ_2 of the cycle, the MPU would have halted after completion of the following instruction. BA will go "High" by time t_{BA} (bus available delay time) after the last instruction cycle. At this point in time, VMA is "Low" and R/W, Address Bus, and the Data Bus are in the high impedance state.

To debug programs it is advantageous to step through programs instruction by instruction. To do this, HALT must be brought "High" for one MPU cycle and then returned "Low" as shown at point B of Fig. 18. Again, the transitions of HALT must occur t_{PCS} before the trailing edge of ϕ_1 . BA will go "Low" at t_{BA} after the leading edge of the next ϕ_1 , indicating that the Address Bus, Data Bus, VMA and R/W lines are back on the bus. A single byte, 2 cycle instruction such as LSR is used for this example also. During the first cycle, the instruction Y is fetched from address M+1. BA returns "High" at t_{BA} on the last cycle of the instruction indicating the MPU is off the bus, if instruction Y had been three cycles, the width of the BA "Low" time would have been increased by one cycle.

Table 2 shows the relation between the state of MPU and signal outputs.

■ MPU INSTRUCTION SET

This Section will provide a brief introduction and discuss their use in developing HD6800 MPU control programs. The HD6800 MPU has a set of 72 different executable source instructions. Included are binary and decimal arithmetic, logical, shift, rotate, load, store, conditional or unconditional branch, interrupt and stack manipulation instructions.

Each of the 72 executable instructions of the source language assembles into 1 to 3 bytes of machine code. The number of bytes depends on the particular instruction and on the addressing mode. (The addressing modes which are available for use with the various executive instructions are discussed later.)

The coding of the first (or only) byte corresponding to an executable instruction is sufficient to identify the instruction and the addressing mode. The hexadecimal equivalents of the 72 instructions in all valid modes of addressing, are shown in Table 3. There are 197 valid machine codes, 59 of the 256 possible codes being unassigned.

When an instruction translates into two or three bytes of code, the second byte, or second and third bytes contain(s) an operand, an address, or information from which an address is obtained during execution.

Microprocessor instructions are often divided into three general classifications; (1) memory reference, so called because they operate on specific memory locations; (2) operating instructions that function without needing a memory reference; (3) I/O instructions for transferring data between the microprocessor and peripheral devices.

In many instances, the HD6800 MPU performs the same operation on both its internal accumulators and the external

memory locations. In addition, the HD6800 MPU allow the MPU to treat peripheral devices exactly like other memory locations, hence, no I/O instructions as such are required. Because of these features, other classifications are more suitable for introducing the HD6800's instruction set: (1) Accumulator and memory operations; (2) Program control operations; (3) Condition Code Register operations.

For Accumulator and Memory Operations, refer to Table 4.

Table 3 Hexadecimal Values of Machine Codes

MSB \ LSB	0	1	2	3	4	5	6	7	8	9	A	B	C	D	E	F
0	*	NOP (IMP)	*	*	*	*	TAP (IMP)	TPA (IMP)	INX (IMP)	DEX (IMP)	CLV (IMP)	SEV (IMP)	CLC (IMP)	SEC (IMP)	CLI (IMP)	SEI (IMP)
1	SBA (A, B)	CBA (A, B)	*	*	*	*	TAB (IMP)	TBA (IMP)	*	DAA (IMP)	*	ABA (IMP)	*	*	*	*
2	BRA (REL)	*	BHI (REL)	BLS (REL)	BCC (REL)	BCS (REL)	BNE (REL)	BEO (REL)	BVC (REL)	BVS (REL)	BPL (REL)	BMI (REL)	BGE (REL)	BLT (REL)	BGT (REL)	BLE (REL)
3	TSX (IMP)	INS (IMP)	PUL (A)	PUL (B)	DES (IMP)	TXS (IMP)	PSH (A)	PSH (B)	*	RTS (IMP)	*	RTI (IMP)	*	*	WAI (IMP)	SWI (IMP)
4	NEG (A)	*	*	COM (A)	LSR (A)	*	ROR (A)	ASR (A)	ASL (A)	ROL (A)	DEC (A)	*	INC (A)	TST (A)	*	CLR (A)
5	NEG (B)	*	*	COM (B)	LSR (B)	*	ROR (B)	ASR (B)	ASL (B)	ROL (B)	DEC (B)	*	INC (B)	TST (B)	*	CLR (B)
6	NEG (IND)	*	*	COM (IND)	LSR (IND)	*	ROR (IND)	ASR (IND)	ASL (IND)	ROL (IND)	DEC (IND)	*	INC (IND)	TST (IND)	JMP (IND)	CLR (IND)
7	NEG (EXT)	*	*	COM (EXT)	LSR (EXT)	*	ROR (EXT)	ASR (EXT)	ASL (EXT)	ROL (EXT)	DEC (EXT)	*	INC (EXT)	TST (EXT)	JMP (EXT)	CLR (EXT)
8	SUB (IMM) (A)	CMP (IMM) (A)	SBC (IMM) (A)	*	AND (IMM) (A)	BIT (IMM) (A)	LDA (IMM) (A)	*	EOR (IMM) (A)	ADC (IMM) (A)	ORA (IMM) (A)	ADD (IMM) (A)	CPX (IMM) (A)	BSR (REL)	LDS (IMM)	*
9	SUB (DIR) (A)	CMP (DIR) (A)	SBC (DIR) (A)	*	AND (DIR) (A)	BIT (DIR) (A)	LDA (DIR) (A)	STA (DIR) (A)	EOR (DIR) (A)	ADC (DIR) (A)	ORA (DIR) (A)	ADD (DIR) (A)	CPX (DIR) (A)	*	LDS (DIR)	STS (DIR)
A	SUB (IND) (A)	CMP (IND) (A)	SBC (IND) (A)	*	AND (IND) (A)	BIT (IND) (A)	LDA (IND) (A)	STA (IND) (A)	EOR (IND) (A)	ADC (IND) (A)	ORA (IND) (A)	ADD (IND) (A)	CPX (IND) (A)	JSR (IND)	LDS (IND)	STS (IND)
B	SUB (EXT) (A)	CMP (EXT) (A)	SBC (EXT) (A)	*	AND (EXT) (A)	BIT (EXT) (A)	LDA (EXT) (A)	STA (EXT) (A)	EOR (EXT) (A)	ADC (EXT) (A)	ORA (EXT) (A)	ADD (EXT) (A)	CPX (EXT) (A)	JSR (EXT)	LDS (EXT)	STS (EXT)
C	SUB (IMM) (B)	CMP (IMM) (B)	SBC (IMM) (B)	*	AND (IMM) (B)	BIT (IMM) (B)	LDA (IMM) (B)	*	EOR (IMM) (B)	ADC (IMM) (B)	ORA (IMM) (B)	ADD (IMM) (B)	*	*	LDX (IMM)	*
D	SUB (DIR) (B)	CMP (DIR) (B)	SBC (DIR) (B)	*	AND (DIR) (B)	BIT (DIR) (B)	LDA (DIR) (B)	STA (DIR) (B)	EOR (DIR) (B)	ADC (DIR) (B)	ORA (DIR) (B)	ADD (DIR) (B)	*	*	LDX (DIR) (B)	STX (DIR) (B)
E	SUB (IND) (B)	CMP (IND) (B)	SBC (IND) (B)	*	AND (IND) (B)	BIT (IND) (B)	LDA (IND) (B)	STA (IND) (B)	EOR (IND) (B)	ADC (IND) (B)	ORA (IND) (B)	ADD (IND) (B)	*	*	LDX (IND)	STX (IND)
F	SUB (EXT) (B)	CMP (EXT) (B)	SBC (EXT) (B)	*	AND (EXT) (B)	BIT (EXT) (B)	LDA (EXT) (B)	STA (EXT) (B)	EOR (EXT) (B)	ADC (EXT) (B)	ORA (EXT) (B)	ADD (EXT) (B)	*	*	LDX (EXT)	STX (EXT)

DIR = Direct Addressing Mode
EXT = Extended Addressing Mode
IMM = Immediate Addressing Mode

IND = Index Addressing Mode
IMP = Implied Addressing Mode
REL = Relative Addressing Mode

A = Accumulator A
B = Accumulator B

Table 4 Accumulator and Memory Operations

Operation	Mnemonic	Addressing Modes										Boolean/ Arithmetic Operation	Cond. Code Reg.					
		IMMED		DIRECT		INDEX		EXTND		IMPLIED			5	4	3	2	1	0
		OP ~ #		OP ~ #		OP ~ #		OP ~ #		OP ~ #			H	I	N	Z	V	C
Add	ADDA	8B	2 2	9B	3 2	AB	5 2	BB	4 3			A + M → A	•	•	•	•	•	•
	ADDB	CB	2 2	DB	3 2	EB	5 2	FB	4 3			B + M → B	•	•	•	•	•	•
Add Acmltrs	ABA									1B	2 1	A + B → A	•	•	•	•	•	•
Add with Carry	ADCA	89	2 2	99	3 2	A9	5 2	B9	4 3			A + M + C → A	•	•	•	•	•	•
And	ADCB	C9	2 2	D9	3 2	E9	5 2	F9	4 3			B + M + C → B	•	•	•	•	•	•
	ANDA	84	2 2	94	3 2	A4	5 2	B4	4 3			A ← M → A	•	•	•	•	•	•
Bit Test	ANDB	C4	2 2	D4	3 2	E4	5 2	F4	4 3			B ← M → B	•	•	•	•	•	•
	BITA	85	2 2	95	3 2	A5	5 2	B5	4 3			A ← M	•	•	•	•	•	•
Clear	BITB	C5	2 2	D5	3 2	E5	5 2	F5	4 3			B ← M	•	•	•	•	•	•
	CLR					6F	7 2	7F	6 3			00 → M	•	•	•	•	•	•
Compare	CLRA									4F	2 1	00 → A	•	•	•	•	•	•
	CLRB									5F	2 1	00 → B	•	•	•	•	•	•
Compare Acmltrs	CMPA	81	2 2	91	3 2	A1	5 2	B1	4 3			A ← M	•	•	•	•	•	•
	CMPB	C1	2 2	D1	3 2	E1	5 2	F1	4 3			B ← M	•	•	•	•	•	•
Complement, 1's	CBA									11	2 1	A ← B	•	•	•	•	•	•
	COM					63	7 2	73	6 3			M → M	•	•	•	•	•	•
Complement, 2's (Negate)	COMA									43	2 1	A ← A	•	•	•	•	•	•
	COMB									53	2 1	B ← B	•	•	•	•	•	•
Decimal Adjust, A	NEG					60	7 2	70	6 3			00 ← M → M	•	•	•	•	•	•
	NEGA									40	2 1	00 ← A → A	•	•	•	•	•	•
Decrement	NEGB									50	2 1	00 ← B → B	•	•	•	•	•	•
	DAA									19	2 1	Converts Binary Add of BCD Characters into BCD Format	•	•	•	•	•	•
Exclusive OR	DEC					6A	7 2	7A	6 3			M ← 1 → M	•	•	•	•	•	•
	DECA									4A	2 1	A ← 1 → A	•	•	•	•	•	•
Increment	DECB									5A	2 1	B ← 1 → B	•	•	•	•	•	•
	EORA	88	2 2	98	3 2	A8	5 2	B8	4 3			A ⊕ M → A	•	•	•	•	•	•
Load Acmltr	EORB	C8	2 2	D8	3 2	E8	5 2	F8	4 3			B ⊕ M → B	•	•	•	•	•	•
	INCA					6C	7 2	7C	6 3			M + 1 → M	•	•	•	•	•	•
Or, Inclusive	INCB									4C	2 1	A + 1 → A	•	•	•	•	•	•
	LDAA	86	2 2	96	3 2	A6	5 2	B6	4 3			M ← A	•	•	•	•	•	•
Push Data	LDAB	C6	2 2	D6	3 2	E6	5 2	F6	4 3			M ← B	•	•	•	•	•	•
	ORAA	8A	2 2	9A	3 2	AA	5 2	BA	4 3			A + M → A	•	•	•	•	•	•
Pull Data	ORAB	CA	2 2	DA	3 2	EA	5 2	FA	4 3			B + M → B	•	•	•	•	•	•
	PSHA									36	4 1	A ← Msp, SP - 1 → SP	•	•	•	•	•	•
Rotate Left	PSHB									37	4 1	B ← Msp, SP - 1 → SP	•	•	•	•	•	•
	PULA									32	4 1	SP + 1 → SP, Msp → A	•	•	•	•	•	•
Rotate Right	PULB									33	4 1	SP + 1 → SP, Msp → B	•	•	•	•	•	•
	ROL					69	7 2	79	6 3			M	•	•	•	•	•	•
Shift Left, Arithmetic	ROLA									49	2 1	A	•	•	•	•	•	•
	ROLB									59	2 1	B	•	•	•	•	•	•
Shift Right, Arithmetic	RORA					66	7 2	76	6 3			M	•	•	•	•	•	•
	RORB									46	2 1	A	•	•	•	•	•	•
Shift Right, Logic	ASL					68	7 2	78	6 3			M	•	•	•	•	•	•
	ASLB									48	2 1	A	•	•	•	•	•	•
Store Acmltr	ASRA					67	7 2	77	6 3			M	•	•	•	•	•	•
	ASRB									58	2 1	B	•	•	•	•	•	•
Subtract	ASRA									47	2 1	A	•	•	•	•	•	•
	ASRB									57	2 1	B	•	•	•	•	•	•
Subtract Acmltrs	LSR					64	7 2	74	6 3			M	•	•	•	•	•	•
	LSRA									44	2 1	A	•	•	•	•	•	•
Subtr with Carry	LSRB									54	2 1	B	•	•	•	•	•	•
	STAA			97	4 2	A7	6 2	B7	5 3			A ← M	•	•	•	•	•	•
Test Zero or Minus	STAB			D7	4 2	E7	6 2	F7	5 3			B ← M	•	•	•	•	•	•
	SUBA	80	2 2	90	3 2	A0	5 2	B0	4 3			A ← M → A	•	•	•	•	•	•
Transfer Acmltrs	SUBB	C0	2 2	D0	3 2	E0	5 2	F0	4 3			B ← M → B	•	•	•	•	•	•
	SBA									10	2 1	A ← B → A	•	•	•	•	•	•
Test Zero or Minus	SBCA	82	2 2	92	3 2	A2	5 2	B2	4 3			A ← M ← C → A	•	•	•	•	•	•
	SBCB	C2	2 2	D2	3 2	E2	5 2	F2	4 3			B ← M ← C → B	•	•	•	•	•	•
Transfer Acmltrs	TAB									16	2 1	A ← B	•	•	•	•	•	•
	TBA									17	2 1	B ← A	•	•	•	•	•	•
Test Zero or Minus	TST					6D	7 2	7D	6 3			M ← 00	•	•	•	•	•	•
	TSTA									4D	2 1	A ← 00	•	•	•	•	•	•
Test Zero or Minus	TSTB									5D	2 1	B ← 00	•	•	•	•	•	•

LEGEND:
 OP Operation Code (Hexadecimal)
 ~ Number of MPU Cycles
 # Number of Program Bytes
 + Arithmetic Plus
 - Arithmetic Minus
 • Boolean AND
 Msp Contents of memory location pointed to be Stack Pointer

CONDITION CODE SYMBOLS:
 H Half-carry from bit 3
 I Interrupt mask
 N Negative (sign bit)
 Z Zero (byte)
 V Overflow, 2's complement
 C Carry from bit 7

CONDITION CODE REGISTER NOTES:
 (Bit set if test is true and cleared otherwise)
 ① (Bit V) Test: Result = 10000000?
 ② (Bit C) Test: Result ≠ 00000000?
 ③ (Bit C) Test: Decimal value of most significant BCD Character greater than nine? (Not cleared if previously set.)
 ④ (Bit V) Test: Operand = 10000000 prior to execution?
 ⑤ (Bit V) Test: Operand = 01111111 prior to execution?
 ⑥ (Bit V) Test: Set equal to result of N ⊕ C after shift has occurred.

PROGRAM CONTROL OPERATIONS

Program Control operation can be subdivided into two categories: (1) Index Register/Stack Pointer instructions; (2) Jump and Branch of operations.

Index Register/Stack Pointer Operations

The instructions for direct operation on the MPU's Index Register and Stack Pointer are summarized in Table 5. Decrement (DEX, DES), increment (INX, INS), load (LDX, LDS), and store (STX, STS) instructions are provided for both. The Compare instruction, CPX, can be used to compare the Index Register to a 16-bit value and update the Condition Code Register accordingly.

The TSX instruction causes the Index Register to be loaded with the address of the last data byte put onto the "stack". The TXS instruction loads the Stack Pointer with a value equal to one less than the current contents of the Index Register. This causes the next byte to be pulled from the "stack" to come from the location indicated by the Index Register. The utility of these two instructions can be clarified by describing the "stack" concept relative to the HMCS 6800 system.

The "stack" can be thought of as a sequential list of data stored in the MPU's read/write memory. The Stack Pointer contains a 16-bit memory address that is used to access the list from one end on a last-in-first-out (LIFO) basis in contrast to the random access mode used by the MPU's other addressing modes.

The HD6800 MPU instruction set and interrupt structure allow extensive use of the stack concept for efficient handling of data movement, subroutines and interrupts. The instructions can be used to establish one or more "stacks" anywhere in read/write memory. Stack length is limited only by the amount of memory that is made available.

Operation of the Stack Pointer with the Push and Pull instructions is illustrated in Figs. 19 and 20. The Push instruction (PSHA) causes the contents of the indicated accumulator (A in

this example) to be stored in memory at the location indicated by the Stack Pointer. The Stack Pointer is automatically decremented by one following the storage operation and is "pointing" to the next empty stack location.

The Pull instruction (PULA or PULB) causes the last byte stacked to be loaded into the appropriate accumulator. The Stack Pointer is automatically incremented by one just prior to the data transfer so that it will point to the last byte stacked rather than the next empty location. Note that the PULL instruction does not "remove" the data from memory; in the example, 1A is still in location (m+1) following execution of PULA. A subsequent PUSH instruction would overwrite than location with the new "pushed" data.

Execution of the Branch to Subroutine (BSR) and Jump to Subroutine (JSR) instructions cause a return address to be save on the stack as shown in Figs. 21 through 23. The stack is decremented after each byte of the return address is pushed onto the stack. For both of the these instructions, the return address is the memory location following the bytes of code that correspond to the BSR and JSR instruction. The code required for BSR or JSR may be either two or three bytes, depending on whether the JSR is in the indexed (two bytes) or the extended (three bytes) addressing mode. Before it is stacked, the Program Counter is automatically incremented the correct number of times to be pointing at the location of the next instruction. The Return from Subroutine instruction, RTS, causes the return address to be retrieved and loaded into the Program Counter as shown in Fig. 24.

There are several operations that cause the status of the MPU to be saved on the stack. The Software Interrupt (SWI) and Wait for Interrupt (WAI) instructions as well as the maskable (TRQ) and non-maskable (NMI) hardware interrupts all cause the MPU's internal registers (except for the Stack Pointer itself) to be stacked as shown in Fig. 25. MPU status is restored by the Return from interrupt, RTI, as shown in Fig. 26.

Table 5 Index Register and Stack Pointer Instructions

Operation	Mnemonic	Addressing Modes										Boolean/ Arithmetic Operation	Cond. Code Reg.							
		IMMED		DIRECT		INDEX		EXTND		IMPLIED			5	4	3	2	1	0		
		OP	~ #	OP	~ #	OP	~ #	OP	~ #	OP	~ #		H	I	N	Z	V	C		
Compare Index Reg	CPX	8C	3 3	9C	4 2	AC	6 2	BC	5 3					(X _H) - (M), (X _L) - (M+1)	•	•	①	†	②	•
Decrement Index Reg	DEX									09	4 1	X - 1 → X	•	•	•	†	•	•	•	•
Decrement Stack Pntr	DES									34	4 1	SP - 1 → SP	•	•	•	•	•	•	•	•
Increment Index Reg	INX									08	4 1	X + 1 → X	•	•	•	†	•	•	•	•
Increment Stack Pntr	INS									31	4 1	SP + 1 → SP	•	•	•	†	•	•	•	•
Load Index Reg	LDX	CE	3 3	DE	4 2	EE	6 2	FE	5 3			M → X _H , (M+1) → X _L	•	•	③	†	R	•	•	
Load Stack Pntr	LDS	8E	3 3	9E	4 2	AE	6 2	BE	5 3			M → SP _H , (M+1) → SP _L	•	•	③	†	R	•	•	
Store Index Reg	STX			DF	5 2	EF	7 2	FF	6 3			X _H → M, X _L → (M + 1)	•	•	③	†	R	•	•	
Store Stack Pntr	STS			9F	5 2	AF	7 2	BF	6 3			SP _H → M, SP _L → (M + 1)	•	•	③	†	R	•	•	
Index Reg → Stack Pntr	TXS									35	4 1	X - 1 → SP	•	•	•	•	•	•	•	•
Stack Pntr → Index Reg	TSX									30	4 1	SP + 1 → X	•	•	•	•	•	•	•	•

- ① (Bit N) Test: Sign bit of most significant (MS) byte of result = 1?
- ② (Bit V) Test: 2's complement overflow from subtraction of ms bytes?
- ③ (Bit N) Test: Result less than zero? (Bit 15 = 1)

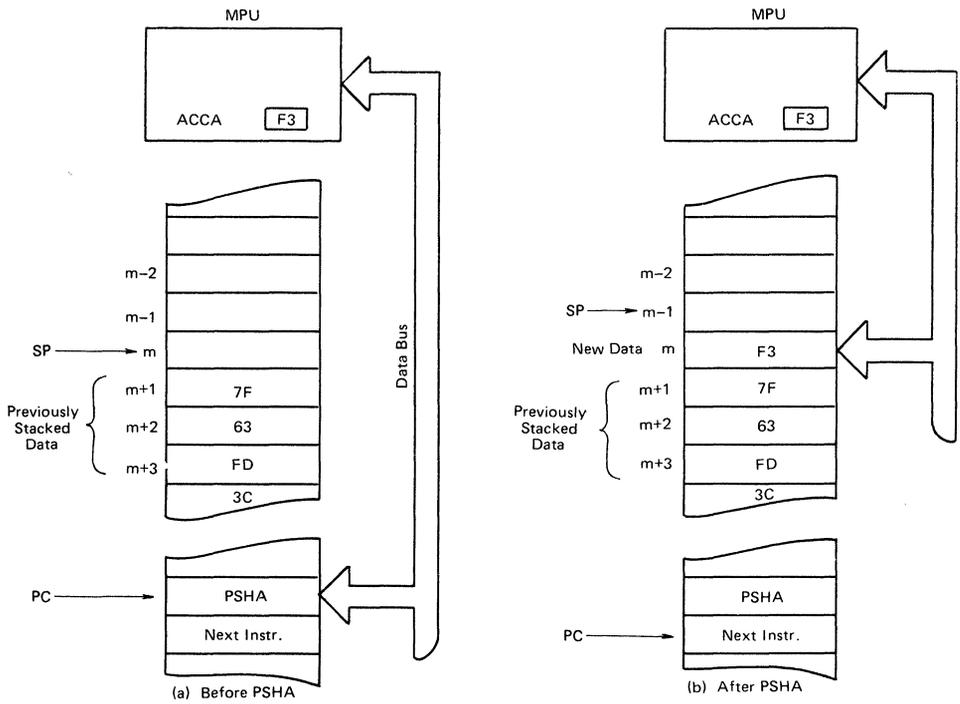


Figure 19 Stack Operation (Push Instruction)

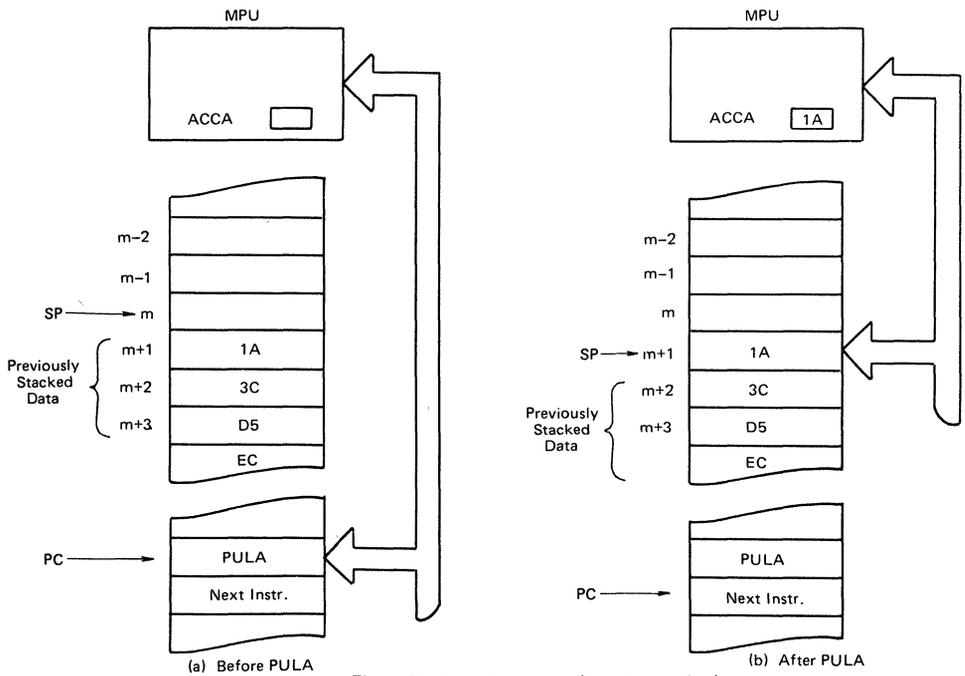


Figure 20 Stack Operation (Pull Instruction)

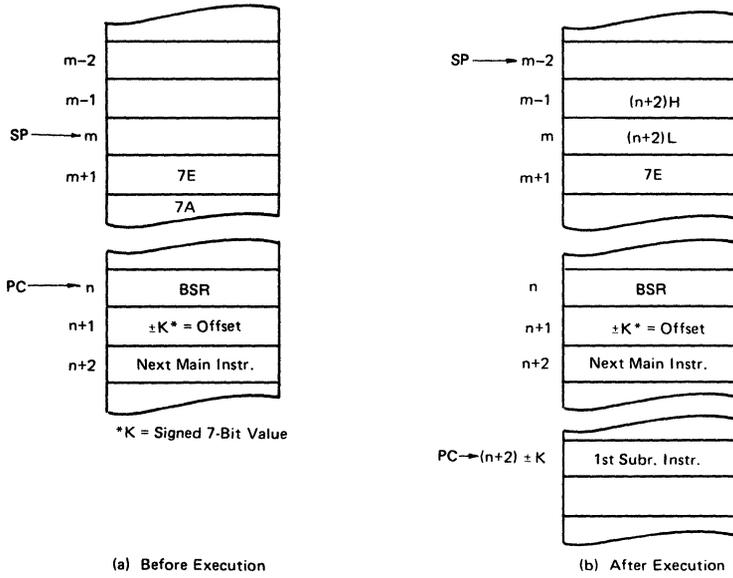


Figure 21 Program Flow for BSR

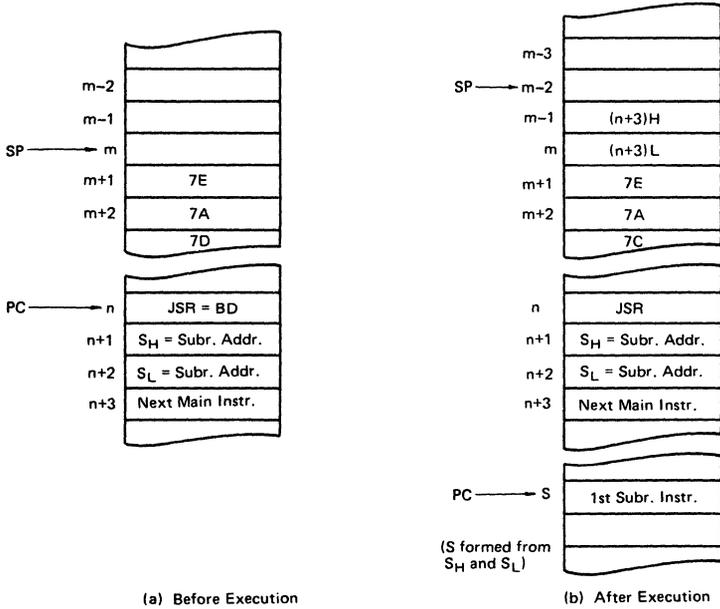


Figure 22 Program Flow for JSR (Extended)

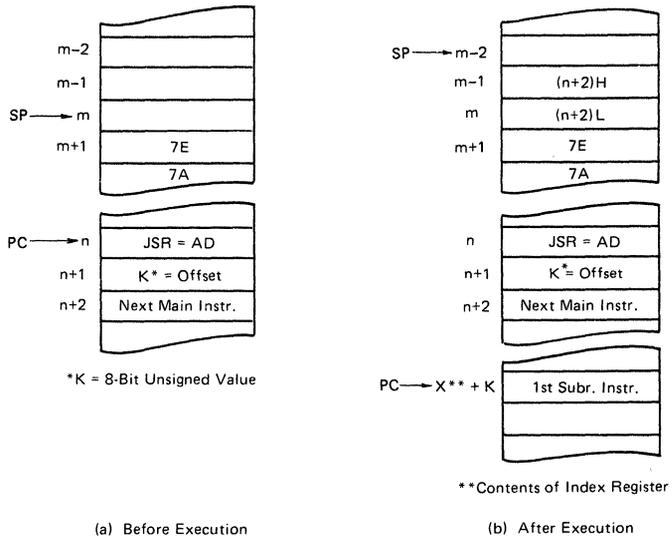


Figure 23 Program Flow for JSR (Indexed)

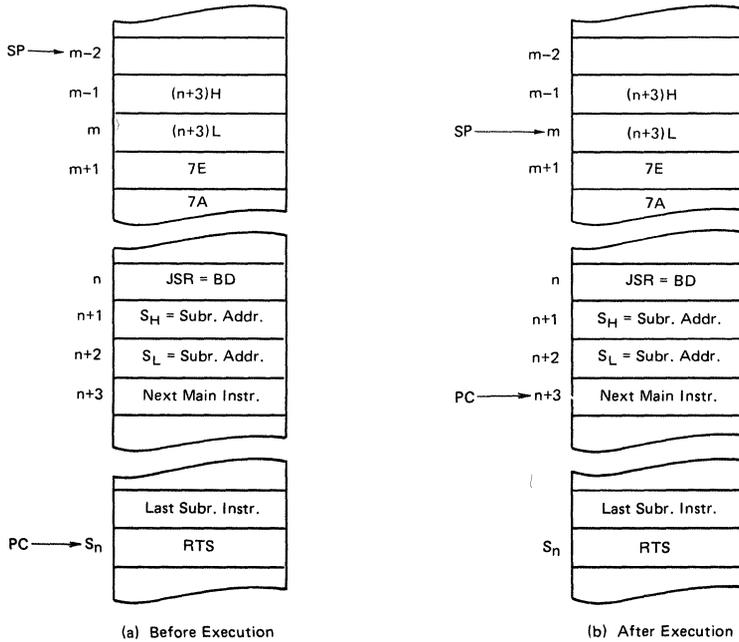
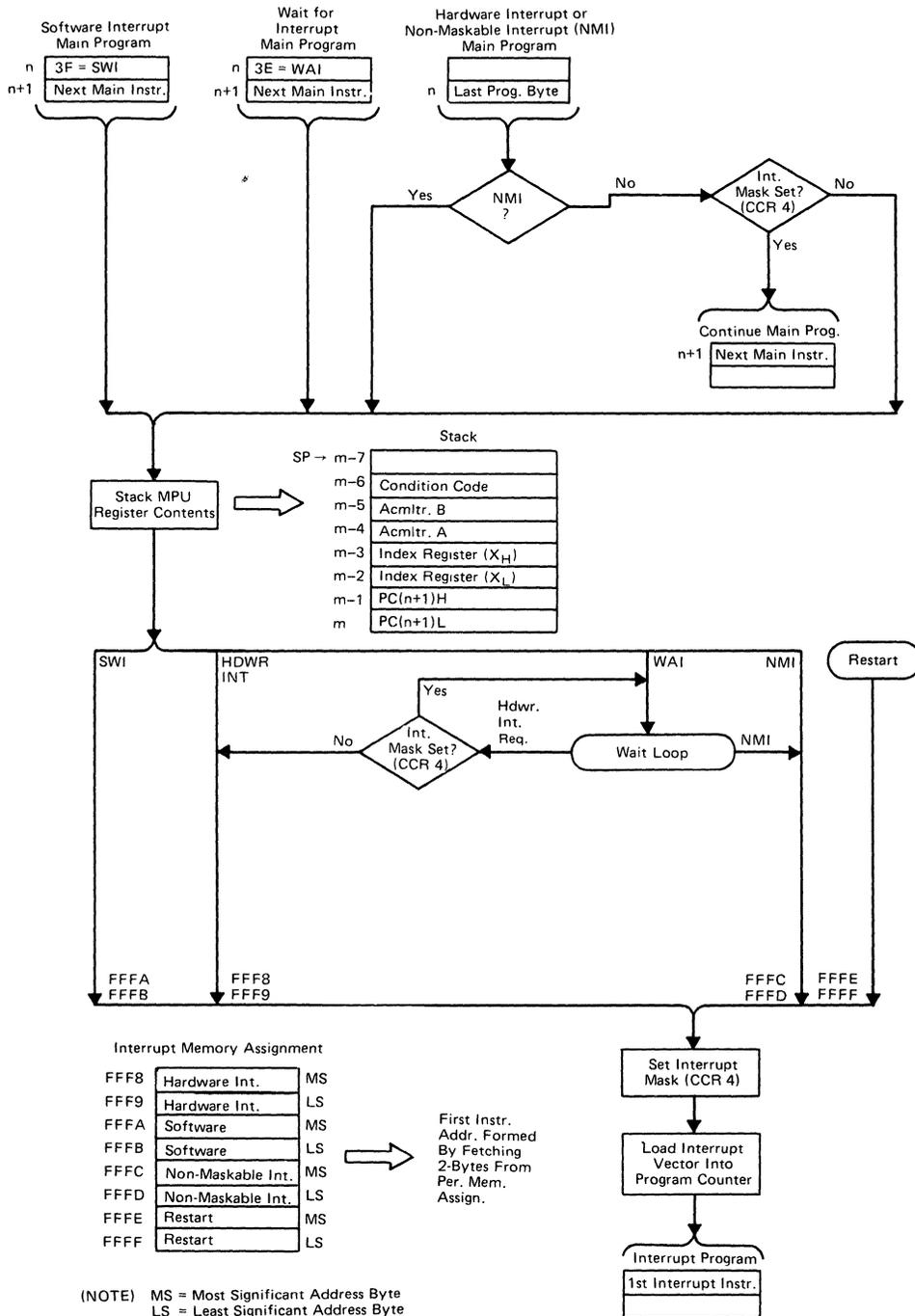


Figure 24 Program Flow for RTS



(NOTE) MS = Most Significant Address Byte
LS = Least Significant Address Byte

Figure 25 Program Flow for Interrupts

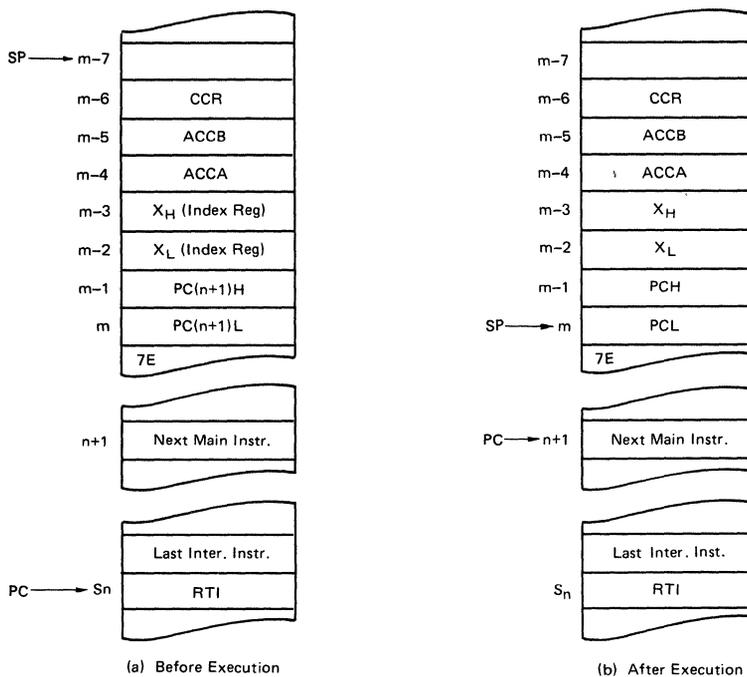


Figure 26 Program Flow for RTI

● Jump and Branch Operation

The Jump and Branch instructions are summarized in Table 6. These instructions are used to control the transfer of operation from one point to another in the control program.

The No Operation instruction, NOP, while included here, is a jump operation in a very limited sense. Its only effect is to increment the Program Counter by one. It is useful during program development as a "stand-in" for some other instruction that is to be determined during debug. It is also used for equalizing the execution time through alternate paths in a control program.

Execution of the Jump Instruction, JMP, and Branch Always, BRA, affects program flow as shown in Fig. 27. When the MPU encounters the Jump (Index) instruction, it adds the offset to the value in the Index Register and uses the result as the address of the next instruction to be executed. In the extended addressing mode, the address of the next instruction to be executed is fetched from the two locations immediately following the JMP instruction. The Branch Always (BRA) instruction is similar to the JMP (extended) instruction except that the relative addressing mode applies and the branch is limited to the range within -125 or +127 bytes of the branch instruction itself. The opcode for the BRA instruction requires one less byte than JMP (extended) but takes one more cycle to execute.

The effect on program flow for the Jump to Subroutine (JSR) and Branch to Subroutine (BSR) is shown in Figs. 21 through 23. Note that the Program Counter is properly in-

cremented to be pointing at the correct return address before it is stacked. Operation of the Branch to Subroutine and Jump to Subroutine (extended) instruction is similar except for the range. The BSR instruction requires less opcode than JSR (2 bytes versus 3 bytes) and also executes one cycle faster than JSR. The Return from Subroutine, RTS, is used at the end of a subroutine to return to the main program as indicated in Fig. 24.

The effect of executing the Software Interrupt, SWI, and the Wait for Interrupt, WAI, and their relationship to the hardware interrupts is shown in Fig. 25. SWI causes the MPU contents to be stacked and then fetches the starting address of the interrupt routine from the memory locations that respond to the addresses FFFA and FFFB. Note that as in the case of the subroutine instructions, the Program Counter is incremented to point at the correct return address before being stacked. The Return from Interrupt instruction, RTI, (Fig. 26) is used at the end of an interrupt routine to restore control to the main program. The SWI instruction is useful for inserting break points in the control program, that is, it can be used to stop operation and put the MPU registers in memory where they can be examined. The WAI instruction is used to decrease the time required to service a hardware interrupt; it stacks the MPU contents and then waits for the interrupt to occur, effectively removing the stacking time from a hardware interrupt sequence.

3. Branch On Overflow Clear (BVC) and Branch On Overflow Set (BVS) tests the state of the V bit to determine if the previous operation caused an arithmetic overflow.
4. Branch On Carry Clear (BCC) and Branch On Carry Set (BCS) tests the state of the C bit to determine if the previous operation caused a carry to occur. BCC and BCS are useful for testing relative magnitude when the values being tested are regarded as unsigned binary numbers, that is, the values are in the range "00" (lowest) of "FF" (highest). BCC following a comparison (CMP) will cause a branch if the (unsigned) value in the accumulator is higher than or the same as the value of the operand. Conversely, BCS will cause a branch if the accumulator value is lower than the operand.

The Fifth complementary pair, Branch On Higher (BHI) and Branch On Lower or Same (BLS) are in a sense complements to BCC and BCS. BHI tests for both C and Z = "0", if used following a CMP, it will cause a branch if the value in the accumulator is higher than the operand. Conversely, BLS will cause a branch if the unsigned binary value in the accumulator is lower than or the same as the operand.

The remaining two pairs are useful in testing results of operations in which the values are regarded as signed two's complement numbers. This differs from the unsigned binary case in the following sense: In unsigned, the orientation is higher or lower; in signed two's complement, the comparison is between larger or smaller where the range of values is between -128 and +127.

Branch On Less Than Zero (BLT) and Branch On Greater Than Or Equal Zero (BGE) test the status bits for $N \oplus V = "1"$ and $N \oplus V = "0"$, respectively. BLT will always cause a branch following an operation in which two negative numbers were added. In addition, it will cause a branch following a CMP in which the value in the accumulator was negative and the operand was positive. BLT will never cause a branch following a CMP in which the accumulator value was positive and the operand negative. BGE, the complement to BLT, will cause a branch following operations in which two positive values were added or in which the result was "0".

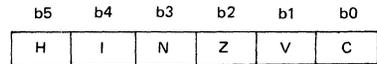
The last pair, Branch On Less Than Or Equal Zero (BLE) and Branch On Greater Than Zero (BGT) test the status bits for $Z \oplus (N + V) = "1"$ and $Z \oplus (N + V) = "0"$, respectively. The action of BLE is identical to that for BLT except that a branch will also occur if the result of the previous result was "0". Conversely, BGT is similar to BGE except that no branch will occur following a "0" result.

■ CONDITION CODE REGISTER OPERATIONS

The Condition Code Register (CCR) is a 6-bit register within the MPU that is useful in controlling program flow during system operation. The bits are defined in Fig. 29.

The instructions shown in Table 7 are available to the user for direct manipulation of the CCR. In addition, the MPU automatically sets or clears the appropriate status bits as many of the other instructions on the condition code register was indicated as they were introduced.

Systems which require an interrupt window to be opened under program control should use a CLI-NOP-SEI sequence rather than CLI-SEI.



H = Half-carry; set whenever a carry from b3 to b4 of the result is generated by ADD, ABA, ADC; cleared if no b3 to b4 carry; not affected by other instructions.

I = Interrupt Mask; set by hardware of software interrupt or SEI instruction; cleared by CLI instruction. (Normally not used in arithmetic operations.) Restored to a "0" as a result of an RTI instruction if IM stored on the stack is "0"

N = Negative; set if high order bit (b7) of result is set; cleared otherwise.

Z = Zero; set if result = "0"; cleared otherwise.

V = Overflow; set if there was arithmetic overflow as a result of the operation; cleared otherwise.

C = Carry; set if there was a carry from the most significant bit (b7) of the result; cleared otherwise.

Figure 29 Condition Code Register Bit Definition

■ ADDRESSING MODES

The MPU operates on 8-bit binary numbers presented to it via the Data Bus. A given number (byte) may represent either data or an instruction to be executed, depending on where it is encountered in the control program. The HD6800 MPU has 72 unique instructions, however, it recognizes and takes action on 197 of the 256 possibilities that can occur using an 8-bit word length. This larger number of instructions results from the fact that many of the executive instructions have more than one addressing mode.

Table 7 Condition Code Register Instructions

Operations	Mnemonic	Addressing Mode			Boolean Operation	Cond. Code Reg.					
		IMPLIED				5	4	3	2	1	0
		OP	~	#		H	I	N	Z	V	C
Clear Carry	CLC	0C	2	1	0 → C	•	•	•	•	•	R
Clear Interrupt Mask	CLI	0E	2	1	0 → I	•	R	•	•	•	•
Clear Overflow	CLV	0A	2	1	0 → V	•	•	•	•	R	•
Set Carry	SEC	0D	2	1	1 → C	•	•	•	•	•	S
Set Interrupt Mask	SEI	0F	2	1	1 → I	•	S	•	•	•	•
Set Overflow	SEV	0B	2	1	1 → V	•	•	•	•	•	S
Acmltr A → CCR	TAP	06	2	1	A → CCR	•	•	•	•	•	•
CCR → Acmltr A	TPA	07	2	1	CCR → A	•	•	•	•	•	•

R = Reset
S = Set
• = Not affected

① (ALL) Set according to the contents of Accumulator A.

These addressing modes refer to the manner in which the program causes the MPU to obtain its instructions and data. The programmer must have a method for addressing the MPU's internal registers and all of the external memory locations.

Selection of the desired addressing mode is made by the user as the source statements are written. Translation into appropriate opcode then depends on the method used. If manual translation is used, the addressing mode is implied in the opcode. For example, the Immediate, Direct, Indexed, and Extended modes may all be used with the ADD instruction. The proper mode is determined by selecting (hexidecimal notation) 8B, 9B, AB, or BB, respectively.

The source statement format includes adequate information for the selection if an assembler program is used to generate the opcode. For instance, the Immediate mode is selected by the

Assembler whenever it encounters the “#” symbol in the operand field. Similarly, an “X” in the operand field causes the Indexed mode to be selected. Only the Relative mode applies to the branch instructions, therefore, the mnemonic instruction itself is enough for the Assembler to determine addressing mode.

For the instructions that use both Direct and Extended modes, the Assembler selects the Direct mode if the operand value is in the range 0~255 and Extended otherwise. There are a number of instructions for which the Extended mode is valid but the Direct is not. For these instructions, the Assembler automatically selects the Extended mode even if the operand is in the 0~255 range. The addressing modes are summarized in Fig. 30.

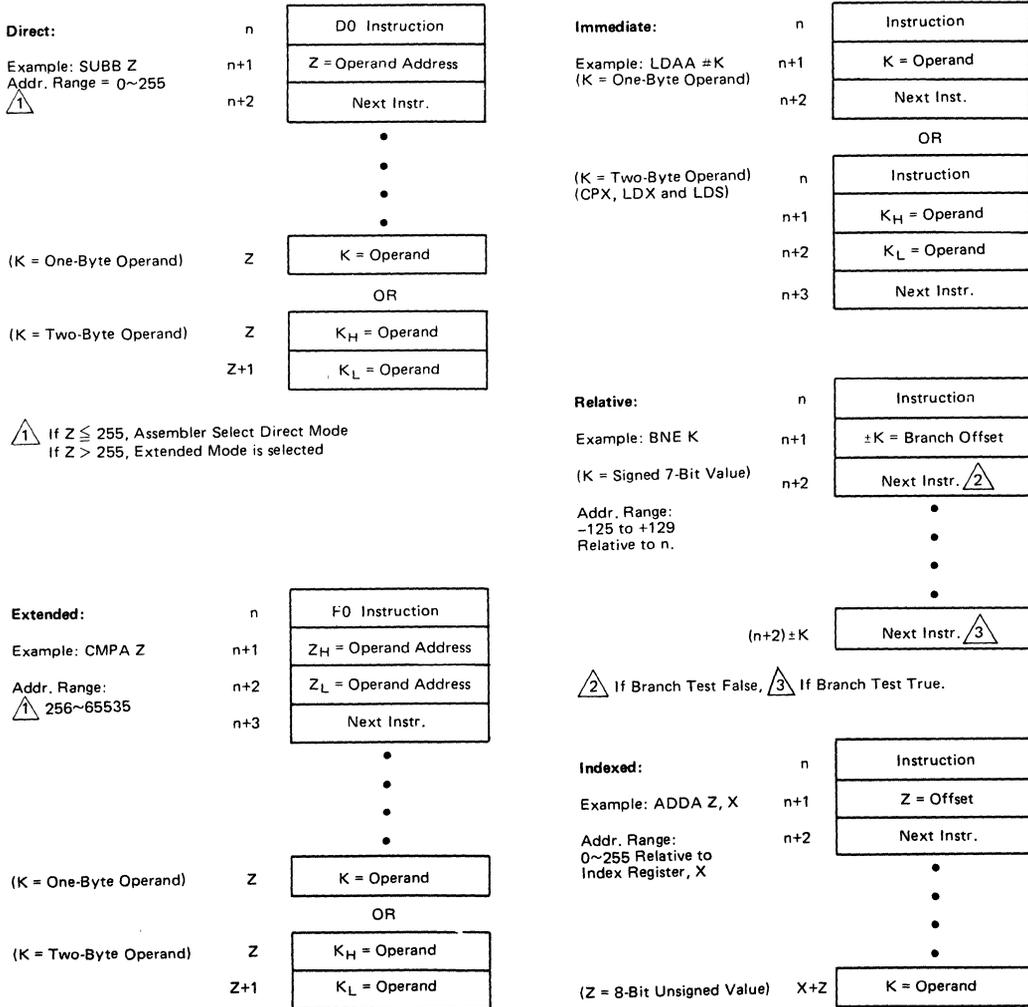


Figure 30 Addressing Mode Summary

● **Implied (Includes "Accumulator Addressing" Mode)**

The successive fields in a statement are normally separated by one or more spaces. An exception to this rule occurs for instructions that use dual addressing in the operand field and for instructions that must distinguish between the two accumulators. In these cases, A and B are "operands" but the space between them and the operator may be omitted. This is commonly done, resulting in apparent four character mnemonics for those instructions.

The addition instruction, ADD, provides an example of dual addressing in the operand fields;

Operator	Operand	Comment
ADDA	MEM12	ADD CONTENTS OF MEM12 TO ACCA
or ADDB	MEM12	ADD CONTENTS OF MEM12 TO ACCB

The example used earlier for the test instruction, TST, also applies to the accumulators and uses the "accumulator addressing mode" to designate which of the two accumulators is being tested:

Operator	Comment
TSTB	TEST CONTENTS OF ACCB
or TSTA	TEST CONTENTS OF ACCA

A number of the instructions either alone or together with an accumulator operand contain all of the address information that is required, that is, "inherent" in the instruction, itself. For instance, the instruction ABA causes the MPU to add the contents of accumulators A and B together and place the result in accumulator A. The instruction INCB, another example of "accumulator addressing", causes the contents of accumulator B to be increased by one. Similarly, INX, increment the Index Register, causes the contents of the Index Register to be increased by one.

Program flow for instructions of this type is illustrated in Figures 31 and 32. In these figures, the general case is shown on the left and a specific example is shown on the right. Numerical examples are in decimal notation. Instructions of this type require only one byte of opcode. Cycle-by-cycle operation of the implied mode is shown in Table 8.

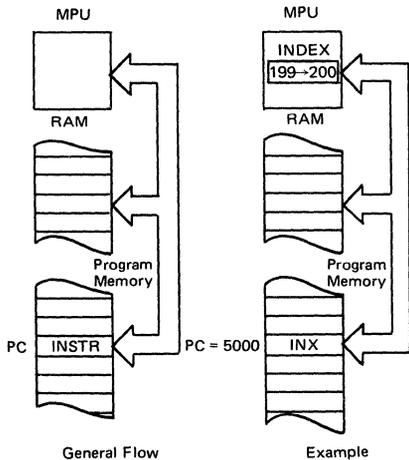


Figure 31 Implied Addressing

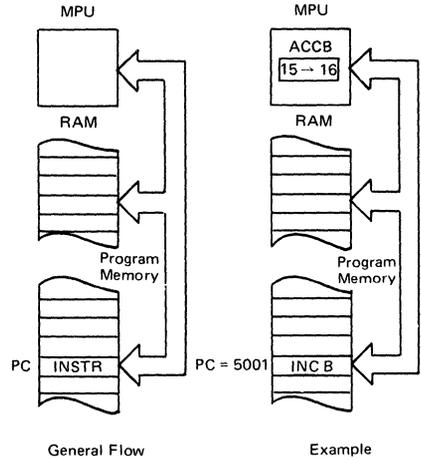


Figure 32 Accumulator Addressing

● **Immediate Addressing Mode**

In the Immediate addressing mode, the operand is the value that is to be operated on. For instance, the instruction

Operator	Operand	Comment
LDA	#25	LOAD 25 INTO ACCA

causes the MPU to "immediately load accumulator A with the value 25"; no further address reference is required. The Immediate mode is selected by preceding the operand value with the "#" symbol. Program flow for this addressing mode is illustrated in Fig. 33.

The operand format allows either properly defined symbols or numerical values. Except for the instructions CPX, LDX, and LDS, the operand may be any value in the range 0 ~ 255. Since Compare Index Register (CPX), Load Index Register (LDX), Load Stack Pointer (LDS), require 16-bit values, the immediate mode for these three instructions require two-byte operands.

Table 9 shows the cycle-by-cycle operation for the immediate addressing mode.

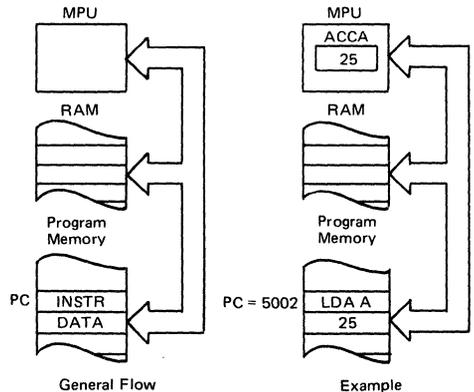


Figure 33 Immediate Addressing Mode

Table 8 Implied Mode Cycle by Cycle Operation

Address Mode and Instructions	Cycle	Cycle #	VMA Line	Address Bus	R/W Line	Data Bus
ABA DAA SEC ASL DEC SEI ASR INC SEV CBA LSR TAB CLC NEG TAP CLI NOP TBA CLR ROL TPA CLV ROR TST COM SBA	2	1	1	Op Code Address	1	Op Code
		2	1	Op Code Address + 1	1	Op Code of Next Instruction
	4	1	1	Op Code Address	1	Op Code
		2	1	Op Code Address + 1	1	Op Code of Next Instruction
		3	0	Previous Register Contents	1	Irrelevant Data (NOTE 1)
		4	0	New Register Contents	1	Irrelevant Data (NOTE 1)
	PSH	4	1	1	Op Code Address	1
2			1	Op Code Address + 1	1	Op Code of Next Instruction
3			1	Stack Pointer	0	Accumulator Data
4			0	Stack Pointer - 1	1	Accumulator Data
PUL	4	1	1	Op Code Address	1	Op Code
		2	1	Op Code Address + 1	1	Op Code of Next Instruction
		3	0	Stack Pointer	1	Irrelevant Data (NOTE 1)
		4	1	Stack Pointer + 1	1	Operand Data from Stack
TSX	4	1	1	Op Code Address	1	Op Code
		2	1	Op Code Address + 1	1	Op Code of Next Instruction
		3	0	Stack Pointer	1	Irrelevant Data (NOTE 1)
		4	0	New Index Register	1	Irrelevant Data (NOTE 1)
TXS	4	1	1	Op Code Address	1	Op Code
		2	1	Op Code Address + 1	1	Op Code of Next Instruction
		3	0	Index Register	1	Irrelevant Data
		4	0	New Stack Pointer	1	Irrelevant Data
RTS	5	1	1	Op Code Address	1	Op Code
		2	1	Op Code Address + 1	1	Irrelevant Data (NOTE 2)
		3	0	Stack Pointer	1	Irrelevant Data (NOTE 1)
		4	1	Stack Pointer + 1	1	Address of Next Instruction (High Order Byte)
		5	1	Stack Pointer + 2	1	Address of Next Instruction (Low Order Byte)
WAI	9	1	1	Op Code Address	1	Op Code
		2	1	Op Code Address + 1	1	Op Code of Next Instruction
		3	1	Stack Pointer	0	Return Address (Low Order Byte)
		4	1	Stack Pointer - 1	0	Return Address (High Order Byte)
		5	1	Stack Pointer - 2	0	Index Register (Low Order Byte)
		6	1	Stack Pointer - 3	0	Index Register (High Order Byte)
		7	1	Stack Pointer - 4	0	Contents of Accumulator A
		8	1	Stack Pointer - 5	0	Contents of Accumulator B
		9	1	Stack Pointer - 6 (NOTE 3)	1	Contents of Cond. Code Register
RTI	10	1	1	Op Code Address	1	Op Code
		2	1	Op Code Address + 1	1	Irrelevant Data (NOTE 2)
		3	0	Stack Pointer	1	Irrelevant Data (NOTE 1)
		4	1	Stack Pointer + 1	1	Contents of Cond. Code Register from Stack
		5	1	Stack Pointer + 2	1	Contents of Accumulator B from Stack
		6	1	Stack Pointer + 3	1	Contents of Accumulator A from Stack
		7	1	Stack Pointer + 4	1	Index Register from Stack (High Order Byte)
		8	1	Stack Pointer + 5	1	Index Register from Stack (Low Order Byte)
		9	1	Stack Pointer + 6	1	Next Instruction Address from Stack (High Order Byte)
		10	1	Stack Pointer + 7	1	Next Instruction Address from Stack (Low Order Byte)
SWI	12	1	1	Op Code Address	1	Op Code
		2	1	Op Code Address + 1	1	Irrelevant Data (NOTE 1)
		3	1	Stack Pointer	0	Return Address (Low Order Byte)
		4	1	Stack Pointer - 1	0	Return Address (High Order Byte)
		5	1	Stack Pointer - 2	0	Index Register (Low Order Byte)
		6	1	Stack Pointer - 3	0	Index Register (High Order Byte)
		7	1	Stack Pointer - 4	0	Contents of Accumulator A
		8	1	Stack Pointer - 5	0	Contents of Accumulator B
		9	1	Stack Pointer - 6	0	Contents of Cond. Code Register
		10	0	Stack Pointer - 7	1	Irrelevant Data (NOTE 1)
		11	1	Vector Address FFFA (Hex)	1	Address of Subroutine (High Order Byte)
		12	1	Vector Address FFFB (Hex)	1	Address of Subroutine (Low Order Byte)

NOTE 1. If device which is addressed during this cycle uses VMA, then the Data Bus will go to the high impedance three-state condition. Depending on bus capacitance, data from the previous cycle may be retained on the Data Bus.

NOTE 2. Data is ignored by the MPU.

NOTE 3. While the MPU is waiting for the interrupt, Bus Available will go "High" indicating the following states of the control lines: VMA is "Low"; Address Bus, R/W, and Data Bus are all in the high impedance state.

Table 9 Immediate Mode Cycle by Cycle Operation

Address Mode and Instructions	Cycle	Cycle #	VMA Line	Address Bus	R/ \bar{W} Line	Data Bus
ADC EOR ADD LDA AND ORA BIT SBC CMP SUB	2	1 2	1 1	Op Code Address Op Code Address + 1	1 1	Op Code Operand Data
CPX LDS LDX	3	1 2 3	1 1 1	Op Code Address Op Code Address + 1 Op Code Address + 2	1 1 1	Op Code Operand Data (High Order Byte) Operand Data (Low Order Byte)

• **Direct and Extended Addressing Modes**

In the Direct and Extended modes of addressing, the operand field of the source statement is the address of the value that is to be operated on. The Direct and Extended modes differ only in the range of memory locations to which they can direct the MPU. Direct addressing generates a single 8-bit operand and, hence, can address only memory locations 0 ~ 255; a two byte operand is generated for Extended addressing, enabling the MPU to reach the remaining memory locations, 256 ~ 65535. An example of Direct addressing and its effect on program flow is illustrated in Fig. 34.

Table 10 shows the cycle-by-cycle operations of this mode.

The MPU, after encountering the opcode for the instruction LDAA (Direct) at memory location 5004 (Program Counter = 5004), looks in the next location, 5005, for the address of the operand. It then sets the program counter equal to the value found there (100 in the example) and fetches the operand, in

this case a value to be loaded into accumulator A, from that location. For instructions requiring a two-byte operand such as LDX (Load the Index Register), the operand bytes would be retrieved from locations 100 and 101.

Extended addressing, Fig. 35, is similar except that a two-byte address is obtained from locations 5007 and 5008 after the LDAB (Extended) opcode shows up in location 5006. Extended addressing can be thought of as the "standard" addressing mode, that is, it is a method of reaching anyplace in memory. Direct addressing, since only one address byte is required, provides a faster method of processing data and generates fewer bytes of control code. In most applications, the direct addressing range, memory locations 0 ~ 255, are reserved for RAM. They are used for data buffering and temporary storage of system variables, the area in which faster addressing is of most value, Cycle-by-cycle operation is shown in Table 11 for Extended Addressing.

Table 10 Direct Mode Cycle by Cycle Operation

Address Mode and Instructions	Cycle	Cycle #	VMA Line	Address Bus	R/ \bar{W} Line	Data Bus
ADC EOR ADD LDA AND ORA BIT SBC CMP SUB	3	1 2 3	1 1 1	Op Code Address Op Code Address + 1 Address of Operand	1 1 1	Op Code Address of Operand Operand Data
CPX LDS LDX	4	1 2 3 4	1 1 1 1	Op Code Address Op Code Address + 1 Address of Operand Operand Address + 1	1 1 1 1	Op Code Address of Operand Operand Data (High Order Byte) Operand Data (Low Order Byte)
STA	4	1 2 3 4	1 1 0 1	Op Code Address Op Code Address + 1 Destination Address Destination Address	1 1 1 0	Op Code Destination Address Irrelevant Data (NOTE 1) Data from Accumulator
STS STX	5	1 2 3 4 5	1 1 0 1 1	Op Code Address Op Code Address + 1 Address of Operand Address of Operand Address of Operand + 1	1 1 1 0 0	Op Code Address of Operand Irrelevant Data (NOTE 1) Register Data (High Order Byte) Register Data (Low Order Byte)

NOTE 1. If device which is address during this cycle uses VMA, then the Data Bus will go to the high impedance three-state condition. Depending on bus capacitance, data from the previous cycle may be retained on the Data Bus.

Table 11 Extended Mode Cycle by Cycle

Address Mode and Instructions	Cycle	Cycle #	VMA Line	Address Bus	R/W Line	Data Bus
STS STX	6	1	1	Op Code Address	1	Op Code
		2	1	Op Code Address + 1	1	Address of Operand (High Order Byte)
		3	1	Op Code Address + 2	1	Address of Operand (Low Order Byte)
		4	0	Address of Operand	1	Irrelevant Data (NOTE 1)
		5	1	Address of Operand	0	Operand Data (High Order Byte)
		6	1	Address of Operand + 1	0	Operand Data (Low Order Byte)
JSR	9	1	1	Op Code Address	1	Op Code
		2	1	Op Code Address + 1	1	Address of Subroutine (High Order Byte)
		3	1	Op Code Address + 2	1	Address of Subroutine (Low Order Byte)
		4	1	Subroutine Starting Address	1	Op Code of Next Instruction
		5	1	Stack Pointer	0	Return Address (Low Order Byte)
		6	1	Stack Pointer - 1	0	Return Address (High Order Byte)
		7	0	Stack Pointer - 2	1	Irrelevant Data (NOTE 1)
		8	0	Op Code Address + 2	1	Irrelevant Data (NOTE 1)
		9	1	Op Code Address + 2	1	Address of Subroutine (Low Order Byte)
JMP	3	1	1	Op Code Address	1	Op Code
		2	1	Op Code Address + 1	1	Jump Address (High Order Byte)
		3	1	Op Code Address + 2	1	Jump Address (Low Order Byte)
ADC EOR ADD LDA AND ORA BIT SBC CMP SUB	4	1	1	Op Code Address	1	Op Code
		2	1	Op Code Address + 1	1	Address of Operand (High Order Byte)
		3	1	Op Code Address + 2	1	Address of Operand (Low Order Byte)
		4	1	Address of Operand	1	Operand Data
		5	1	Address of Operand + 1	1	Operand Data (Low Order Byte)
CPX LDS LDX	5	1	1	Op Code Address	1	Op Code
		2	1	Op Code Address + 1	1	Address of Operand (High Order Byte)
		3	1	Op Code Address + 2	1	Address of Operand (Low Order Byte)
		4	1	Address of Operand	1	Operand Data (High Order Byte)
		5	1	Address of Operand + 1	1	Operand Data (Low Order Byte)
STA A STA B	5	1	1	Op Code Address	1	Op Code
		2	1	Op Code Address + 1	1	Destination Address (High Order Byte)
		3	1	Op Code Address + 2	1	Destination Address (Low Order Byte)
		4	0	Operand Destination Address	1	Irrelevant Data (NOTE 1)
		5	1	Operand Destination Address	0	Data from Accumulator
ASL LSR ASR NEG CLR ROL COM ROR DEC TST INC	6	1	1	Op Code Address	1	Op Code
		2	1	Op Code Address + 1	1	Address of Operand (High Order Byte)
		3	1	Op Code Address + 2	1	Address of Operand (Low Order Byte)
		4	1	Address of Operand	1	Current Operand Data
		5	0	Address of Operand	1	Irrelevant Data (NOTE 1)
		6	1/0 (NOTE 2)	Address of Operand	0	New Operand Data (NOTE 2)

NOTE 1. If device which is addressed during this cycle uses VMA, then the Data Bus will go to the high impedance three-state condition.

Depending on bus capacitance, data from the previous cycle may be retained on the Data Bus.

NOTE 2. For TST, VMA = 0 and Operand data does not change.

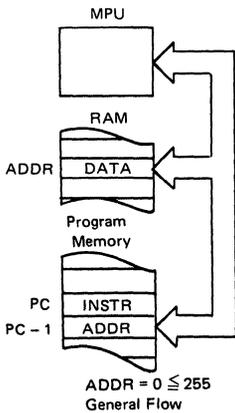
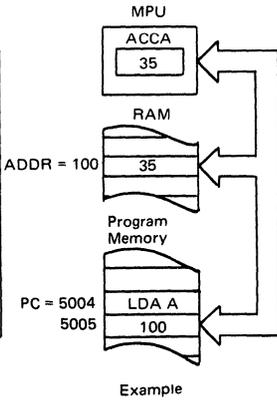
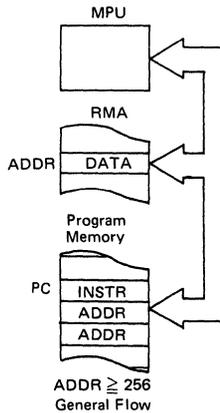


Figure 34 Direct Addressing Mode



Example



Example

Figure 35 Extended Addressing Mode

● **Relative Address Mode**

In both the Direct and Extended modes, the address obtained by the MPU is an absolute numerical address. The Relative addressing mode, implemented for the MPU's branch instructions, specifies a memory location relative to the Program Counter's current location. Branch instructions generate two bytes of machine code, one for the instruction opcode and one for the "relative" address (see Fig. 36). Since it is desirable to be able to branch in either direction, the 8-bit address byte is interpreted as a signed 7-bit value; the 8th bit of the operand is treated as a sign bit, "0" = plus and "1" = minus. The remaining seven bits represent the numerical value. This result in a relative addressing range of ±127 with respect to the location of the branch instruction itself. However, the branch range is computed with respect to the next instruction that would be executed if the branch conditions are not satisfied. Since two byte are generated, the next instruction is located at PC+2. If, D is defined as the address of the branch destination, the range is then;

$$(PC+2) - 128 \leq D \leq (PC+2) + 127$$

or $PC - 126 \leq D \leq PC + 129$

that is, the destination of the branch instruction must be within -126 to +129 memory locations of the branch instruction itself. For transferring control beyond this range, the unconditional jump (JMP), jump to subroutine (JSR), and return from subroutine (RTS) are used.

In Fig. 36, when the MPU encounters the opcode for BEQ (Branch if result of last instruction was zero), it tests the Zero bit in the Condition Code Register. If that bit is "0", indicating a non-zero result, the MPU continues execution with the next instruction (in location 5010 in Fig. 36). If the previous result was zero, the branch condition is satisfied and the MPU adds the offset, 15 in this case, to PC+2 and branches to location 5025 for the next instruction.

The branch instructions allow the programmer to efficiently direct the MPU to one point or another in the control program depending on the outcome of test results. Since the control program is normally in read-only memory and cannot be changed, the relative address used in execution of branch instructions is a constant numerical value. Cycle-by-cycle operation is shown in Table 12 for relative addressing.

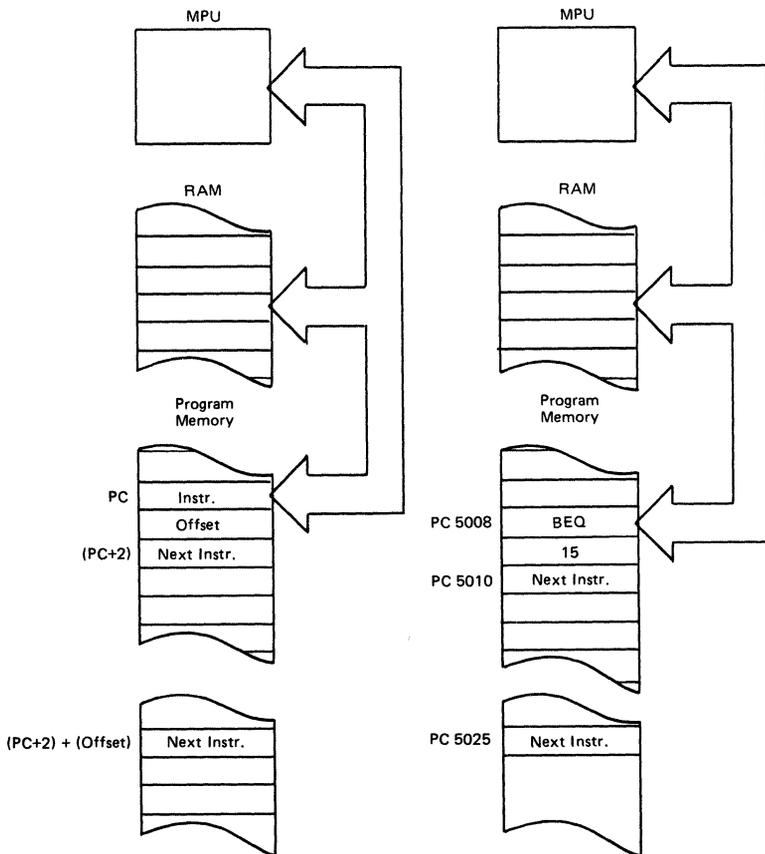


Figure 36 Relative Addressing Mode

Table 12 Relative Mode Cycle-by-Cycle Operation

Address Mode and Instructions	Cycle	Cycle #	VMA Line	Address Bus	R/W Line	Data Bus
BCC BHI BNE	4	1	1	Op Code Address	1	Op Code
BCS BLE BPL		2	1	Op Code Address + 1	1	Branch Offset
BEQ BLS BRA		3	0	Op Code Address + 2	1	Irrelevant Data (NOTE 1)
BGE BLT BVC		4	0	Branch Address	1	Irrelevant Data (NOTE 1)
BGT BMI BVS	8	1	1	Op Code Address	1	Op Code
BSR		2	1	Op Code Address + 1	1	Branch Offset
		3	0	Return Address of Main Program	1	Irrelevant Data (NOTE 1)
		4	1	Stack Pointer	0	Return Address (Low Order Byte)
		5	1	Stack Pointer - 1	0	Return Address (High Order Byte)
		6	0	Stack Pointer - 2	1	Irrelevant Data (NOTE 1)
		7	0	Return Address of Main Program	1	Irrelevant Data (NOTE 1)
		8	0	Subroutine Address	1	Irrelevant Data (NOTE 1)

NOTE 1. If device which is addressed during this cycle uses VMA, then the Data Bus will go to the high impedance three-state condition. Depending on bus capacitance, data from the previous cycle may be retained on the Data Bus.

• Indexed Addressing Mode

With Indexed addressing the numerical address is variable and depend on the current contents of the Index Register. A source statement such as

```

Operator  Operand      Comment
STAA     X             PUT A IN INDEXED LOCATION
    
```

causes the MPU to store the contents of accumulator A in the memory location specified by the contents of the Index Register (recall that the label X is reserved to designate the Index Register). Since there are instructions for manipulating X during program execution (LDX, INX, DEX, etc.), the Indexed addressing mode provides a dynamic "on the fly" way to modify program activity.

The operand field can also contain a numerical value that will be automatically added to X during execution. This format is illustrated in Fig. 37.

When the MPU encounters the LDAB (Indexed) opcode in location 5006, it looks in the next memory location for the value to be added to X (5 in the example) and calculates the required address by adding 5 to the present Index Register value of 400. In the operand format, the offset may be represented by a label or a numerical value in the range 0 ~ 255 as in the example. In the earlier example, STAA X, the operand is equivalent to 0, X, that is, the "0" may be omitted when the desired address is equal to X. Table 13 shows the cycle-by-cycle operation for the Indexed Mode of Addressing.

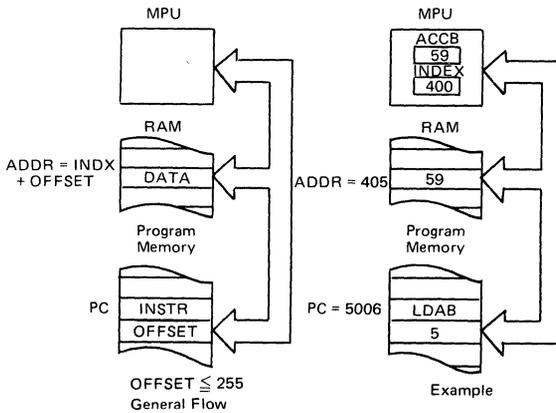


Figure 37 Indexed Addressing Mode

Table 13 Indexed Mode Cycle by Cycle

Address Mode and Instructions	Cycle	Cycle #	VMA Line	Address Bus	R/W Line	Data Bus
JMP	4	1	1	Op Code Address	1	Op Code
		2	1	Op Code Address + 1	1	Offset
		3	0	Index Register	1	Irrelevant Data (NOTE 1)
		4	0	Index Register Plus Offset (w/o Carry)	1	Irrelevant Data (NOTE 1)
ADC EOR ADD LDA AND ORA BIT SBC CMP SUB	5	1	1	Op Code Address	1	Op Code
2		1	Op Code Address + 1	1	Offset	
3		0	Index Register	1	Irrelevant Data (NOTE 1)	
4		0	Index Register Plus Offset (w/o Carry)	1	Irrelevant Data (NOTE 1)	
5		1	Index Register Plus Offset	1	Operand Data	
CPX LDS LDX	6	1	1	Op Code Address	1	Op Code
2		1	Op Code Address + 1	1	Offset	
3		0	Index Register	1	Irrelevant Data (NOTE 1)	
4		0	Index Register Plus Offset (w/o Carry)	1	Irrelevant Data (NOTE 1)	
5		1	Index Register Plus Offset	1	Operand Data (High Order Byte)	
6		1	Index Register Plus Offset + 1	1	Operand Data (Low Order Byte)	
STA	6	1	1	Op Code Address	1	Op Code
		2	1	Op Code Address + 1	1	Offset
		3	0	Index Register	1	Irrelevant Data (NOTE 1)
		4	0	Index Register Plus Offset (w/o Carry)	1	Irrelevant Data (NOTE 1)
		5	0	Index Register Plus Offset	1	Irrelevant Data (NOTE 1)
		6	1	Index Register Plus Offset	0	Operand Data
ASL LSR ASR NEG CLR ROL COM ROR DEC TST INC	7	1	1	Op Code Address	1	Op Code
2		1	Op Code Address + 1	1	Offset	
3		0	Index Register	1	Irrelevant Data (NOTE 1)	
4		0	Index Register Plus Offset (w/o Carry)	1	Irrelevant Data (NOTE 1)	
5		1	Index Register Plus Offset	1	Current Operand Data	
6		0	Index Register Plus Offset	1	Irrelevant Data (NOTE 1)	
7		1/0 (NOTE 2)	Index Register Plus Offset	0	New Operand Data (NOTE 2)	
STS STX	7	1	1	Op Code Address	1	Op Code
2		1	Op Code Address + 1	1	Offset	
3		0	Index Register	1	Irrelevant Data (NOTE 1)	
4		0	Index Register Plus Offset (w/o Carry)	1	Irrelevant Data (NOTE 1)	
5		0	Index Register Plus Offset	1	Irrelevant Data (NOTE 1)	
6		1	Index Register Plus Offset	0	Operand Data (High Order Byte)	
7		1	Index Register Plus Offset + 1	0	Operand Data (Low Order Byte)	
JSR	8	1	1	Op Code Address	1	Op Code
		2	1	Op Code Address + 1	1	Offset
		3	0	Index Register	1	Irrelevant Data (NOTE 1)
		4	1	Stack Pointer	0	Return Address (Low Order Byte)
		5	1	Stack Pointer - 1	0	Return Address (High Order Byte)
		6	0	Stack Pointer - 2	1	Irrelevant Data (NOTE 1)
		7	0	Index Register	1	Irrelevant Data (NOTE 1)
		8	0	Index Register Plus Offset (w/o Carry)	1	Irrelevant Data (NOTE 1)

NOTE 1. If Device which is addressed during this cycle uses VMA, then the Data Bus will go to the high impedance three-state condition. Depending on bus capacitance, data from the previous cycle may be retained on the Data Bus.

NOTE 2. For TST, VMA = 0 and Operand data does not change.

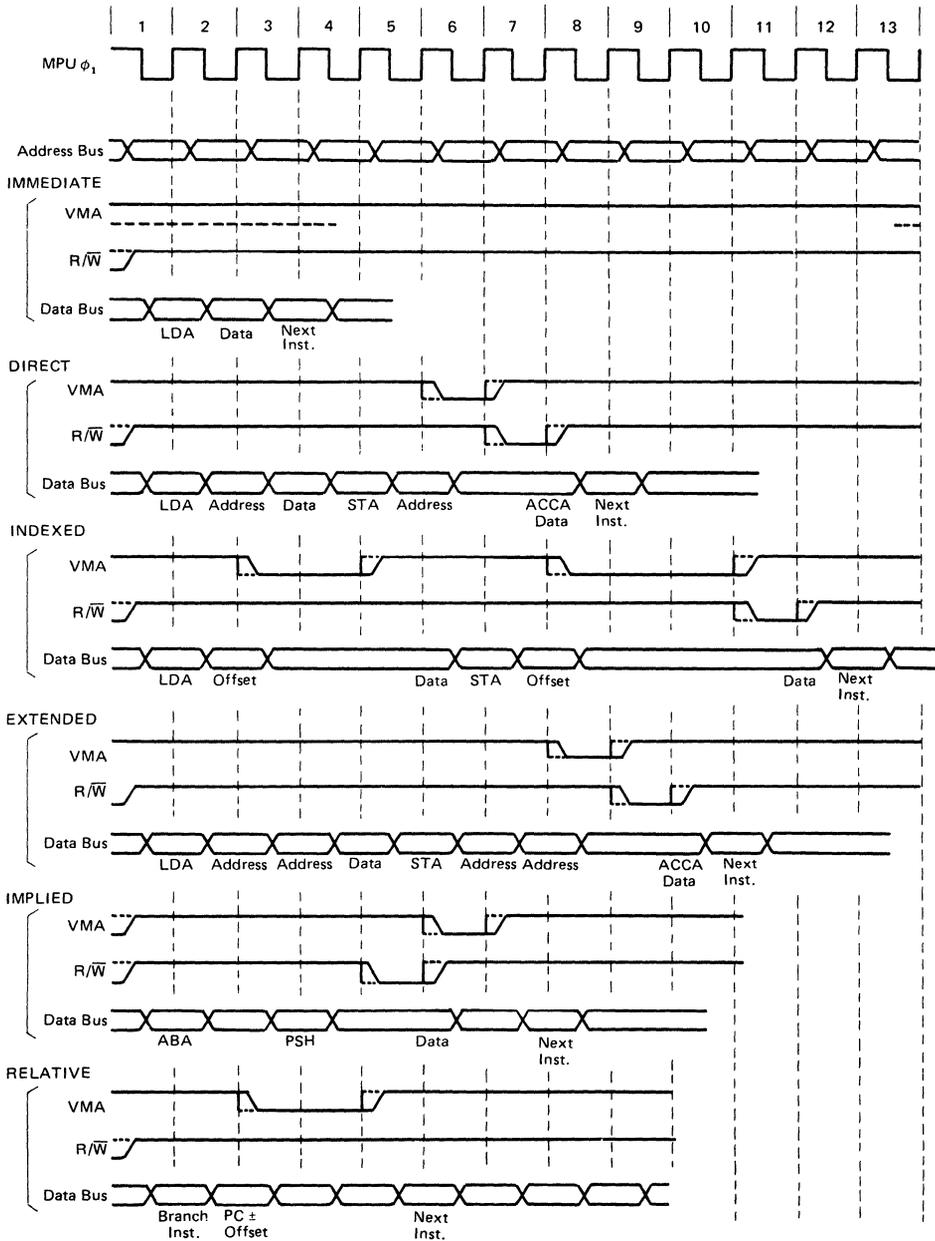


Figure 38 Example of Execution Timing in Each Addressing Mode

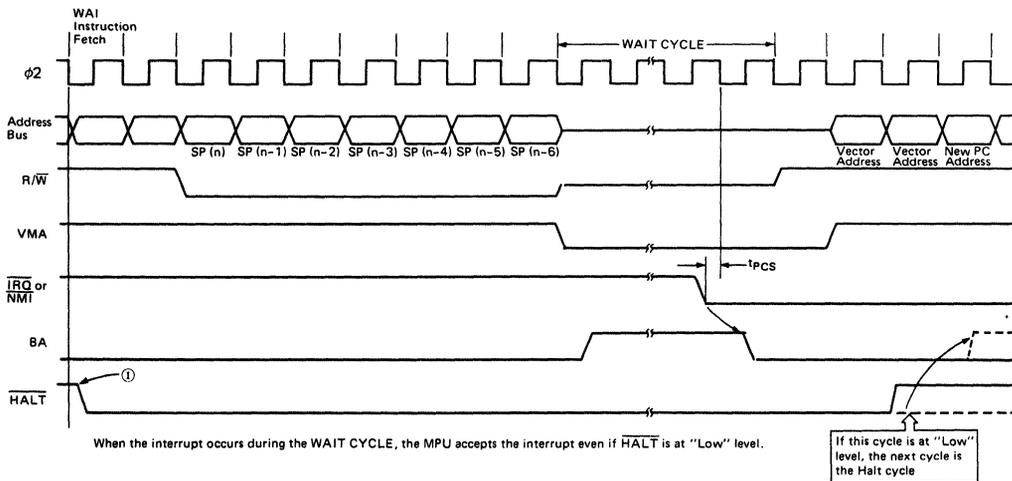
■ NOTE FOR THE RELATION BETWEEN WAI INSTRUCTION AND HALT OPERATION OF HD6800

When $\overline{\text{HALT}}$ input signal is asserted to "Low" level, the MPU will be halted after the execution of the current instruction except WAI instruction.

The "Halt" signal is not accepted after the fetch cycle of the WAI instruction (See ① in Fig. 39). In the case of the "WAI" instruction, the MPU enters the "WAIT" cycle after stacking the internal registers and

outputs the "High" level on the BA line.

When an interrupt request signal is input to the MPU, the MPU accepts the interrupt regardless the "Halt" signal and releases the "WAIT" state and outputs the interrupt's vector address. If the "Halt" signal is "Low" level, the MPU halts after the fetch of new PC contents. The sequence is shown below.



When the interrupt occurs during the WAIT CYCLE, the MPU accepts the interrupt even if $\overline{\text{HALT}}$ is at "Low" level.

Figure 39 HD6800 WAIT CYCLE & $\overline{\text{HALT}}$ Request

HD6802

MPU (Microprocessor with Clock and RAM)

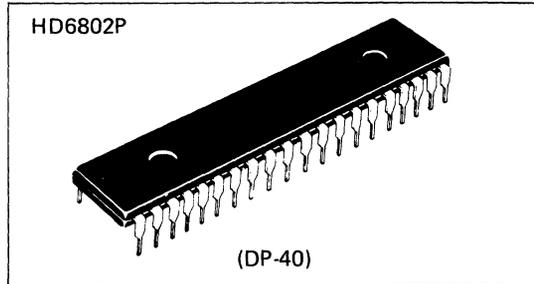
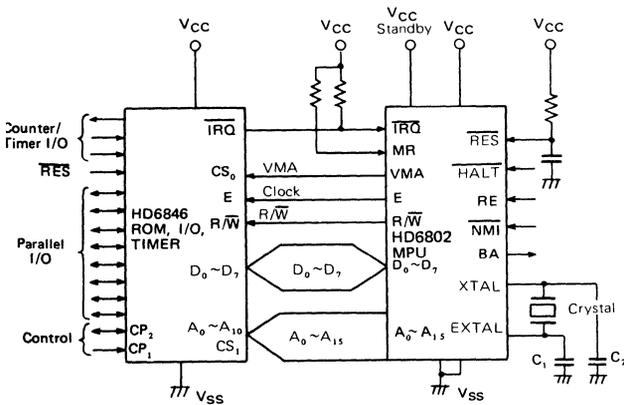
The HD6802 is a monolithic 8-bit microprocessor that contains all the registers and accumulators of the present HD6800 plus an internal clock oscillator and driver on the same chip. In addition, the HD6802 has 128 bytes of RAM on the chip located at hex addresses 0000 to 007F. The first 32 bytes of RAM, at hex addresses 0000 to 001F, may be retained in a low power mode by utilizing V_{CC} standby, thus facilitating memory retention during a power-down situation.

The HD6802 is completely software compatible with the HD6800 as well as the entire HMCS6800 family of parts. Hence, the HD6802 is expandable to 65k words.

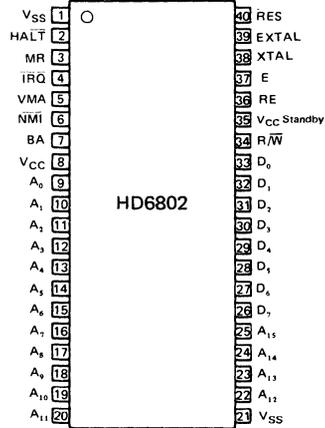
■ FEATURES

- On-Chip Clock Circuit
- 128 × 8 Bit On-Chip RAM
- 32 Bytes of RAM are Retainable
- Software-Compatible with the HD6800
- Expandable to 65k words
- Standard TTL-Compatible Inputs and Outputs
- 8 Bit Word Size
- 16 Bit Memory Addressing
- Interrupt Capability
- Compatible with MC6802

■ BLOCK DIAGRAM



■ PIN ARRANGEMENT



(Top View)

■ ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Value	Unit
Supply Voltage	V_{CC}^* $V_{CC} \text{ Standby}^*$	-0.3 ~ +7.0	V
Input Voltage	V_{in}^*	-0.3 ~ +7.0	V
Operating Temperature	T_{opr}	-20 ~ +75	°C
Storage Temperature	T_{stg}	-55 ~ +150	°C

* With respect to V_{SS} (SYSTEM GND)

(NOTE) Permanent LSI damage may occur if maximum ratings are exceeded. Normal operation should be under recommended operating conditions. If these conditions are exceeded, it could affect reliability of LSI.

■ RECOMMENDED OPERATING CONDITIONS

Item	Symbol	min	typ	max	Unit	
Supply Voltage	V_{CC}^* $V_{CC} \text{ Standby}^*$	4.75	5.0	5.25	V	
Input Voltage	V_{IL}^*	-0.3	-	0.8	V	
	V_{IH}^*	Except \overline{RES}	2.0	-	V_{CC}	V
		\overline{RES}	4.25	-	V_{CC}	V
Operation Temperature	T_{opr}	-20	25	75	°C	

* With respect to V_{SS} (SYSTEM GND)

■ ELECTRICAL CHARACTERISTICS

● DC CHARACTERISTICS ($V_{CC}=5.0V\pm 5\%$, $V_{CC} \text{ Standby}=5.0V\pm 5\%$, $V_{SS}=0V$, $T_a=-20\sim+75^\circ\text{C}$, unless otherwise noted.)

Item	Symbol	Test Condition	min	typ**	max	Unit	
Input "High" Voltage	Except \overline{RES}		2.0	-	V_{CC}	V	
	\overline{RES}		4.25	-	V_{CC}		
Input "Low" Voltage	Except \overline{RES}		-0.3	-	0.8	V	
	\overline{RES}		-0.3	-	0.8		
Output "High" Voltage	$D_0\sim D_7, E$	V_{OH}	$I_{OH} = -205\mu\text{A}$	2.4	-	-	V
	$A_0\sim A_{1S}, R/\overline{W}, \overline{VMA}$		$I_{OH} = -145\mu\text{A}$	2.4	-	-	
	BA		$I_{OH} = -100\mu\text{A}$	2.4	-	-	
Output "Low" Voltage		V_{OL}	$I_{OL} = 1.6\text{mA}$	-	-	0.4	V
Three State (Off State) Input Current	$D_0\sim D_7$	I_{TSI}	$V_{in} = 0.4\sim 2.4\text{V}$	-10	-	10	μA
Input Leakage Current	Except $D_0\sim D_7$ ****	I_{in}	$V_{in} = 0\sim 5.25\text{V}$	-2.5	-	2.5	μA
Power Dissipation		P_D^*		-	0.6	1.2	W
Input Capacitance	$D_0\sim D_7$	C_{in}	$V_{in}=0V, T_a=25^\circ\text{C}, f=1.0\text{MHz}$	-	10	12.5	pF
	Except $D_0\sim D_7$			-	6.5	10	
Output Capacitance	$A_0\sim A_{1S}, R/\overline{W}, BA, \overline{VMA}, E$	C_{out}	$V_{in}=0V, T_a=25^\circ\text{C}, f=1.0\text{MHz}$	-	-	12	pF

* In power-down mode, maximum power dissipation is less than 42mW.

** $T_a=25^\circ\text{C}, V_{CC}=5V$

*** As \overline{RES} input has hysteresis character, applied voltage up to 2.4V is regarded as "Low" level when it goes up from 0V.

**** Does not include EXTAL and XTAL, which are crystal inputs.

● AC CHARACTERISTICS ($V_{CC}=5.0V\pm 5\%$, $V_{CC\ Standby}=5.0V\pm 5\%$, $V_{SS}=0V$, $T_a=-20\sim+75^\circ C$, unless otherwise noted.)

1. CLOCK TIMING CHARACTERISTICS

Item	Symbol	Test Condition	min	typ	max	Unit
Frequency of Operation	Input Clock $\div 4$	f	0.1	—	1.0	MHz
	Crystal Frequency	f_{XTAL}	1.0	—	4.0	
Cycle Time	t_{cyc}	Fig. 2, Fig. 3	1.0	—	10	μs
Clock Pulse Width	"High" Level	$PW_{\phi H}$	450	—	4500	ns
	"Low" Level	$PW_{\phi L}$				
Clock Fall Time	t_{ϕ}	0.8V ~ 2.4V(Fig.2, Fig.3)	—	—	25	ns

2. READ/WRITE TIMING

Item	Symbol	Test Condition	min	typ*	max	Unit
Address Delay	t_{AD}	Fig. 2, Fig. 3, Fig. 6	—	—	270	ns
Peripheral Read Access Time	t_{acc}	Fig. 2	—	—	530	ns
Data Setup Time (Read)	t_{DSR}	Fig. 2	100	—	—	ns
Input Data Hold Time	t_H	Fig. 2	10	—	—	ns
Output Data Hold Time	t_H	Fig. 3	20	—	—	ns
Address Hold Time (Address, R/ \bar{W} , VMA)	t_{AH}	Fig. 2, Fig. 3	10	—	—	ns
Data Delay Time (Write)	t_{DDW}	Fig. 3	—	—	225	ns
Bus Available Delay	t_{BA}	Fig. 4, Fig. 5, Fig. 7, Fig. 8	—	—	250	ns
Processor Controls Processor Control Setup Time Processor Control Rise and Fall Time (Measured at 0.8V and 2.0V)	t_{PCS}	Fig. 4~Fig. 7, Fig. 12	200	—	—	ns
	t_{PCr} t_{PCf}	Fig. 4~Fig. 7, Fig. 12, Fig. 13, Fig. 16	—	—	100	ns

* $T_a = 25^\circ C$, $V_{CC} = 5V$

3. POWER DOWN SEQUENCE TIMING, POWER UP RESET TIMING AND MEMORY READY TIMING

Item	Symbol	Test Condition	min	typ	max	Unit
RAM Enable Reset Time (1)	t_{RE1}	Fig. 13	150	—	—	ns
RAM Enable Reset Time (2)	t_{RE2}	Fig. 13	E-3 cycles	—	—	
Reset Release Time	t_{LRES}	Fig. 12	20*	—	—	ms
RAM Enable Reset Time (3)	t_{RE3}	Fig. 12	0	—	—	ns
Memory Ready Setup Time	t_{SMR}	Fig. 16	300	—	—	ns
Memory Ready Hold Time	t_{HMR}	Fig. 16	0	—	200	ns

* $t_{RES} = 20$ msec min. for S type, 50 msec min. for R type.

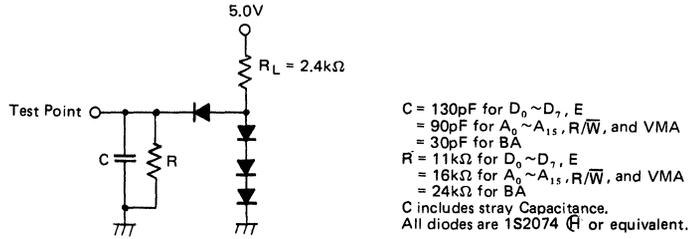


Figure 1 Bus Timing Test Load

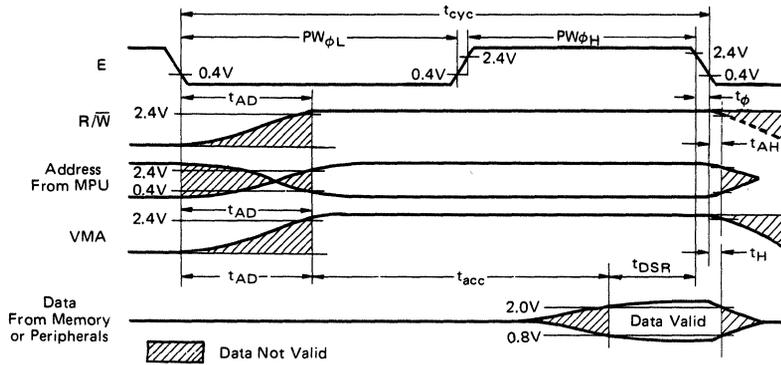


Figure 2 Read Data from Memory or Peripherals

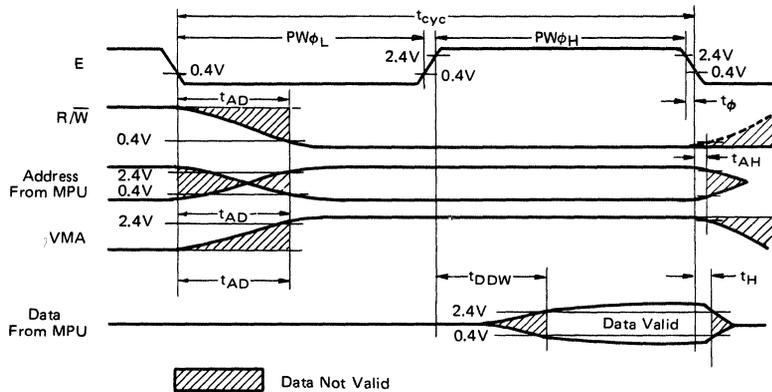


Figure 3 Write Data in Memory or Peripherals

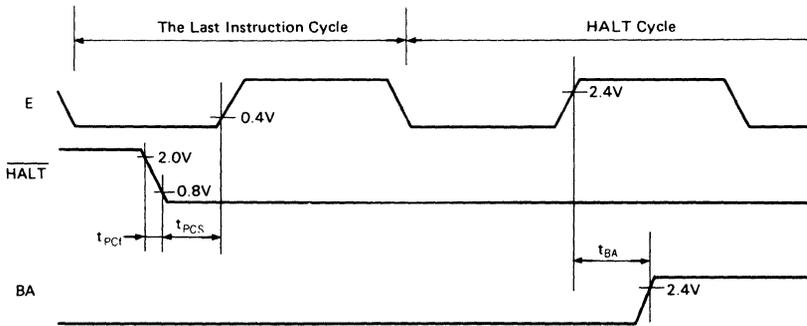


Figure 4 Timing of $\overline{\text{HALT}}$ and BA

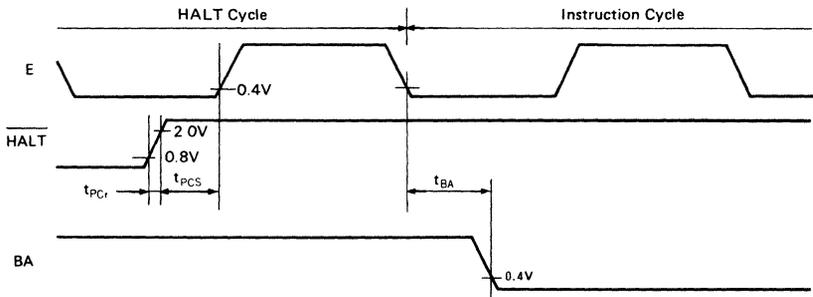


Figure 5 Timing of $\overline{\text{HALT}}$ and BA

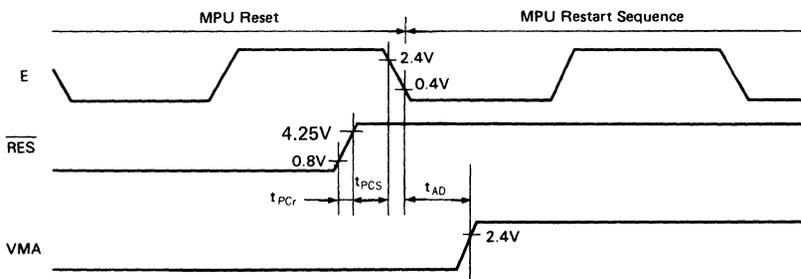


Figure 6 $\overline{\text{RES}}$ and MPU Restart Sequence

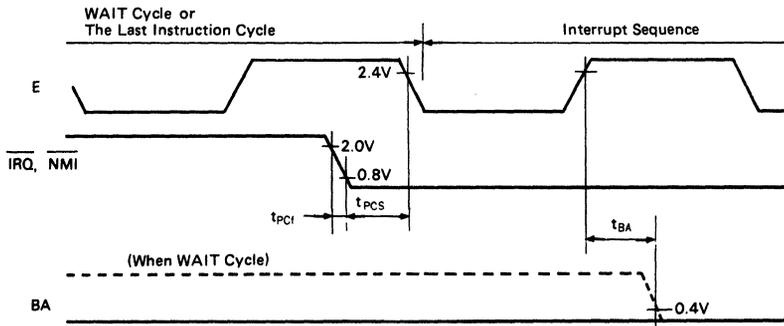


Figure 7 $\overline{\text{IRQ}}$ and $\overline{\text{NMI}}$ Interrupt Timing

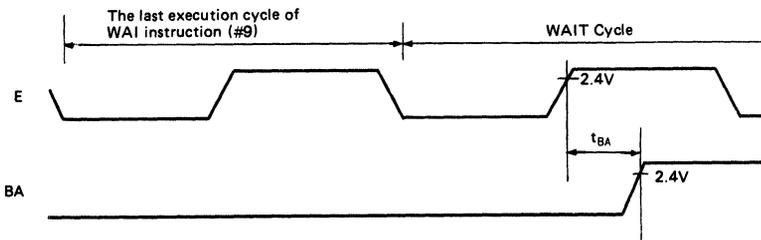


Figure 8 WAI Instruction and BA Timing

■ MPU REGISTERS

A general block diagram of the HD6802 is shown in Fig. 9. As shown, the number and configuration of the registers are the same as for the HD6800. The 128 × 8 bit RAM has been added to the basic MPU. The first 32 bytes may be operated in a low power mode via a V_{CC} standby. These 32 bytes can be retained during power-up and power-down conditions via the RE signal.

The MPU has three 16-bit registers and three 8-bit registers available for use by the programmer (Fig. 10).

● Program Counter (PC)

The program counter is a two byte (16-bit) register that points to the current program address.

● Stack Pointer (SP)

The stack pointer is a two byte (16-bit) register that contains the address of the next available location in an external push-down/pop-up stack. This stack is normally a random access Read/Write memory that may have any location (address) that is convenient. In those applications that require storage of information in the stack when power is lost, the stack must be non-volatile.

● Index Register (IX)

The index register is a two byte register that is used to store data or a sixteen bit memory address for the Indexed mode of memory addressing.

● Accumulators (ACCA, ACCB)

The MPU contains two 8-bit accumulators that are used to hold operands and results from an arithmetic logic unit(ALU).

● Condition Code Register (CCR)

The condition code register indicates the results of an Arithmetic Logic Unit operation: Negative(N), Zero(Z), Overflow(V), Carry from bit7(C), and half carry from bit3(H). These bits of the Condition Code Register are used as testable conditions for the conditional branch instructions. Bit 4 is the interrupt mask bit(I). The used bits of the Condition Code Register (B6 and B7) are ones.

Fig. 11 shows the order of saving the microprocessor status within the stack.

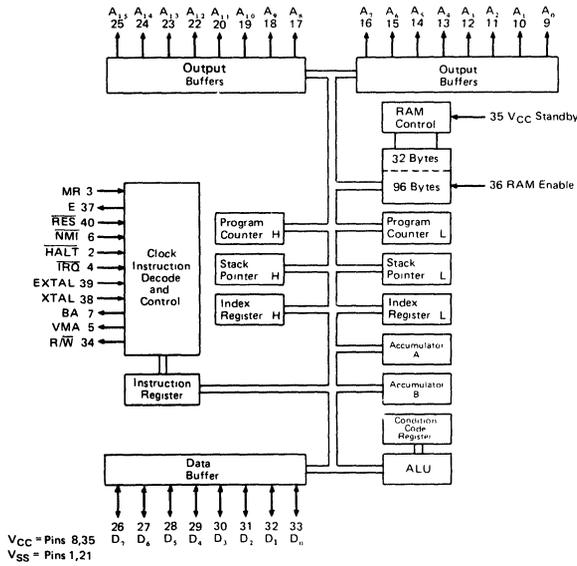


Figure 9 Expanded Block Diagram

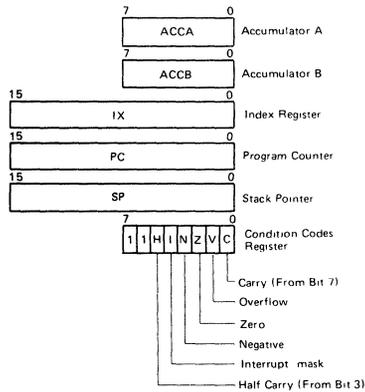


Figure 10 Programming Model of The Microprocessing Unit

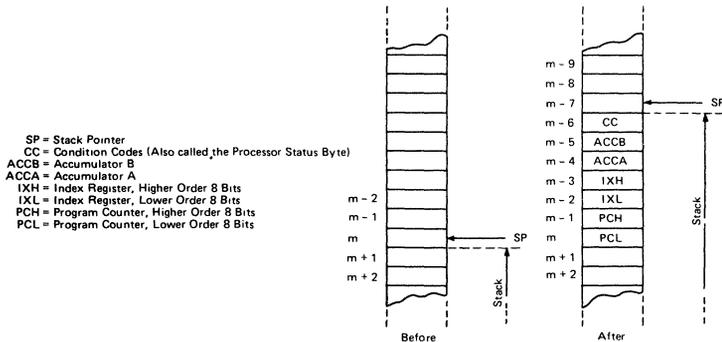


Figure 11 Saving The Status of The Microprocessor in The Stack

■ HD6802 MPU SIGNAL DESCRIPTION

Proper operation of the MPU requires that certain control and timing signals be provided to accomplish specific functions and that other signal lines be monitored to determine the state of the processor. These control and timing signals for the HD6802 are similar to those of the HD6800 except that TSC, DBE, ϕ_1 , ϕ_2 input, and two unused pins have been eliminated, and the following signal and timing lines have been added.

RAM Enable (RE)

Crystal Connections EXTAL and XTAL

Memory Ready(MR)

V_{CC} Standby

Enable ϕ_2 Output(E)

The following is a summary of the HD6802 MPU signals:

● Address Bus (A₀ ~ A₁₅)

Sixteen pins are used for the address bus. The outputs are capable of driving one standard TTL load and 90pF.

● Data Bus (D₀ ~ D₇)

Eight pins are used for the data bus. It is bidirectional, transferring data to and from the memory and peripheral devices. It also has three-state output buffers capable of driving one standard TTL load and 130pF.

Data Bus will be in the output mode when the internal RAM is accessed. This prohibits external data entering the MPU. It should be noted that the internal RAM is fully decoded from \$0000 to \$007F. External RAM at \$0000 to \$007F must be disabled when internal RAM is accessed.

● HALT

When this input is in the "Low" state, all activity in the machine will be halted: This input is level sensitive.

In the halt mode, the machine will stop at the end of an instruction. Bus Available will be at a "High" state. Valid Memory Address will be at a "Low" state. The address bus will display the address of the next instruction.

To insure single instruction operation, transition of the HALT line must not occur during the last 250ns of E and the HALT line must go "High" for one Clock cycle.

HALT should be tied "High" if not used. This is good engineering design practice in general and necessary to insure proper operation of the part.

● Read/Write (R/W)

This TTL compatible output signals the peripherals and memory devices whether the MPU is in a Read ("High") or Write ("Low") state. The normal standby state of this signal is Read ("High"). When the processor is halted, it will be in the logical one state ("High").

This output is capable of driving one standard TTL load and 90pF.

● Valid Memory Address (VMA)

This output indicates to peripheral devices that there is a valid address on the address bus. In normal operation, this signal should be utilized for enabling peripheral interfaces such as the PIA and ACIA. This signal is not three-state. One standard TTL load and 90pF may be directly driven by this active high signal.

● Bus Available (BA)

The Bus Available signal will normally be in the "Low" state. When activated, it will go to the "High" state indicating that the microprocessor has stopped and that the address bus is available (but not in a three-state condition). This will occur if the HALT line is in the "Low" state or the processor is in the wait state as a result of the execution of a WAI instruction. At such time, all three-state output drivers will go to their off state and other

outputs to their normally inactive level.

The processor is removed from the wait state by the occurrence of a maskable (mask bit I=0) or nonmaskable interrupt. This output is capable of driving one standard TTL load and 30pF.

● Interrupt Request (IRQ)

This level sensitive input requests that an interrupt sequence be generated within the machine. The processor will wait, until it completes the current instruction that is being executed before it recognizes the request. At that time, if the interrupt mask bit in the Condition Code Register is not set, the machine will begin an interrupt sequence. The index Register, Program Counter, Accumulators, and Condition Code Register are stored away on the stack. Next the MPU will respond to the interrupt request by setting the interrupt mask bit high so that no further interrupts may occur. At the end of the cycle, a 16-bit address will be loaded that points to a vectored address which is located in memory locations FFF8 and FFF9. An address loaded at these locations causes the MPU to branch to an interrupt routine in memory.

The HALT line must be in the "High" state for interrupts to be serviced. Interrupts will be latched internally while HALT is "Low".

A 3k Ω external resistor to V_{CC} should be used for wire-OR and optimum control of interrupts.

● Reset (RES)

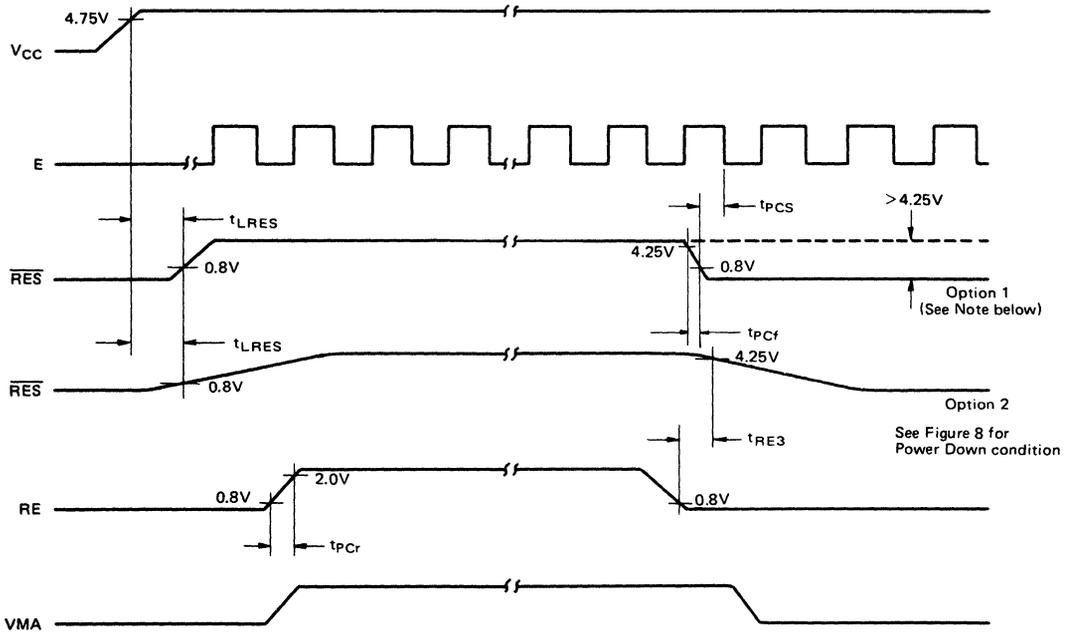
This input is used to reset and start the MPU from a power-down condition, resulting from a power failure or an initial start-up of the processor. When this line is "Low", the MPU is inactive and the information in the registers will be lost. If a "High" level is detected on the input, this will signal the MPU to begin the restart sequence. This will start execution of a routine to initialize the processor from its reset condition. All the higher order address lines will be forced "High". For the restart, the last two(FFFE, FFFF) locations in memory will be used to load the program that is addressed by the program counter. During the restart routine, the interrupt mask bit is set and must be reset before the MPU can be interrupted by IRQ. Power-up and reset timing and power-down sequences are shown in Fig. 12 and Fig. 13 respectively.

● Non-Maskable Interrupt (NMI)

A low-going edge on this input requests that a non-mask-interrupt sequence be generated within the processor. As with the IRQ signal, the processor will complete the current instruction that is being executed before it recognizes the NMI signal. The interrupt mask bit in the Condition Code Register has no effect on NMI.

The Index Register, Program Counter, Accumulators, and Condition Code Register are stored away on the stack. At the end of the cycle, a 16-bit address will be loaded that points to a vectored address which is located in memory locations FFFC and FFFD. An address loaded at these locations causes the MPU to branch to a non-maskable interrupt routine in memory. A 3k Ω external resistor to V_{CC} should be used for wire-OR and optimum control of interrupts.

Inputs IRQ and NMI are hardware interrupt lines that are sampled when E is "High" and will start the interrupt routine on a "Low" E following the completion of an instruction. IRQ and NMI should be tied "High" if not used. This is good engineering design practice in general and necessary to insure proper operation of the part. Fig. 14 is a flowchart describing the major decision paths and interrupt vectors of the microprocessor. Table 1 gives the memory map for interrupt vectors.



(NOTE) If option 1 is chosen, $\overline{\text{RES}}$ and RE pins can be tied together.

Figure 12 Power-up and Reset Timing

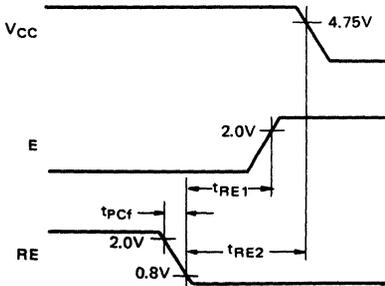


Figure 13 Power-down Sequence

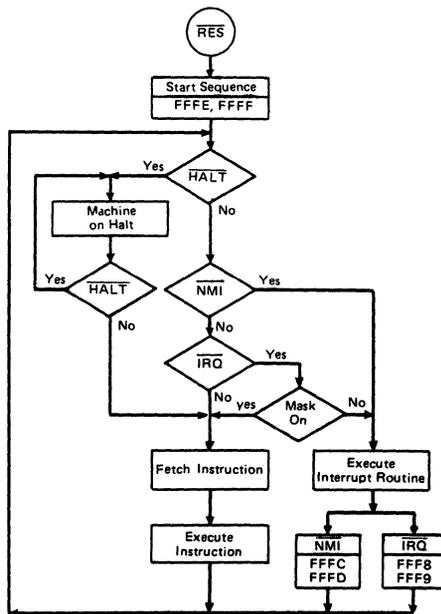


Figure 14 MPU Flow Chart

Table 1 Memory Map for Interrupt Vectors

MS	Vector	LS	Description
FFFE	FFFF		Restart (RES)
FFFC	FFFD		Non-Maskable Interrupt (NMI)
FFFA	FFFB		Software Interrupt (SWI)
FFF8	FFF9		Interrupt Request (IRQ)

• **RAM Enable (RE)**

A TTL-compatible RAM enable input controls the on-chip RAM of the HD6802. When placed in the "High" state, the on-chip memory is enabled to respond to the MPU controls. In the "Low" state, RAM is disabled. This pin may also be utilized to disable reading and writing the on-chip RAM during a power-down situation. RAM enable must be "Low" three cycles before V_{CC} goes below 4.75V during power-down.

RE should be tied to the correct "High" or "Low" state if not used. This is good engineering design practice in general and necessary to insure proper operation of the part.

• **EXTAL and XTAL**

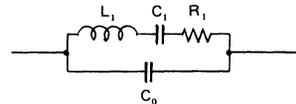
The HD6802 has an internal oscillator that may be crystal controlled. These connections are for a parallel resonant fundamental crystal (AT cut). A divide-by-four circuit has been added to the HD6802 so that a 4MHz crystal may be used in lieu of a 1MHz crystal for a more cost-effective system. Pin39 of the HD6802 may be driven externally by a TTL input signal if a separate clock is required. Pin38 is to be left open in this mode.

An RC network is not directly usable as a frequency source on pins 38 and 39. An RC network type TTL or CMOS oscillator will work well as long as the TTL or CMOS output drives the HD6802.

If an external clock is used, it may not be halted for more than $4.5\mu s$. The HD6802 is a dynamic part except for the internal RAM, and requires the external clock to retain information.

Conditions for Crystal (4 MHz)

- AT Cut Parallel resonant
- $C_0 = 7 \text{ pF max.}$
- $R_1 = 80\Omega \text{ max.}$



Crystal Equivalent Circuit

Recommended Oscillator (4MHz)

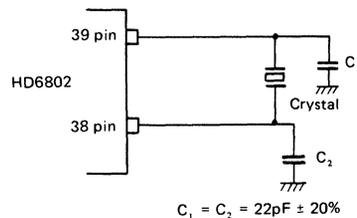


Figure 15 Crystal Oscillator

When using the crystal, see the note for Board Design of the Oscillation Circuit in HD6802.

• **Memory Ready (MR)**

MR is a TTL compatible input control signal which allows stretching of E. When MR is "High", E will be in normal operation. When MR is "Low", E may be stretched integral multiples of half periods, thus allowing interface to slow memories. Memory Ready timing is shown in Fig. 16.

MR should be tied "High" if not used. This is good engineering design practice in general and necessary to insure proper operation of the part. A maximum stretch is $4.5\mu s$.

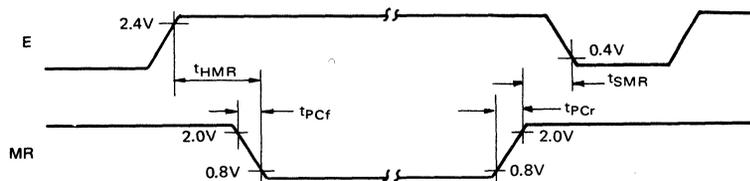


Figure 16 Memory Ready Control Function

● **Enable (E)**

This pin supplies the clock for the MPU and the rest of the system. This is a single phase, TTL compatible clock. This clock may be conditioned by a Memory Ready Signal. This is equivalent to ϕ_2 on the HD6800.

● **V_{CC} Standby**

This pin supplies the dc voltage to the first 32 bytes of RAM as well as the RAM Enable (RE) control logic. Thus retention of data in this portion of the RAM on a power up, power-down, or standby condition is guaranteed at the range of 4.0 V to 5.25 V. Maximum current drain at 5.25V is 8mA.

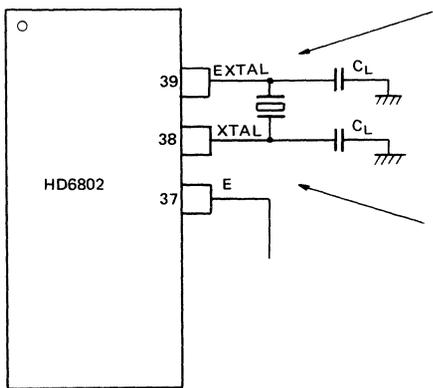
■ **MPU INSTRUCTION SET**

The HD6802 has a set of 72 different instructions. Included are binary and decimal arithmetic, logical, shift, rotate, load, store, conditional or unconditional branch, interrupt and stack manipulation instructions.

This instruction set is the same as that for the 6800MPU(HD6800 etc.) and is not explained again in this data sheet.

■ **NOTE FOR BOARD DESIGN OF THE OSCILLATION CIRCUIT IN HD6802**

In designing the board, the following notes should be taken when the crystal oscillator is used.

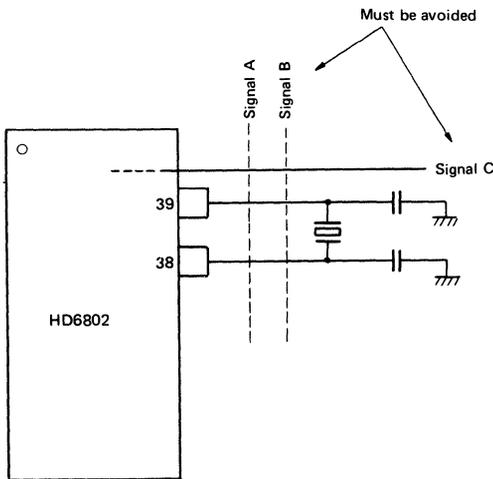


Crystal oscillator and load capacity C_L must be placed near the LSI as much as possible.

(Normal oscillation may be disturbed when external noise is induced to pin 38 and 39.)

Pin 38 signal line should be wired apart from pin 37 signal line as much as possible. Don't wire them in parallel, or normal oscillation may be disturbed when E signal is feedbacked to XTAL.

The following design must be avoided.



A signal line or a power source line must not cross or go near the oscillation circuit line as shown in the left figure to prevent the induction from these lines and perform the correct oscillation. The resistance among XTAL, EXTAL and other pins should be over $10M\Omega$.

Figure 17 Note for Board Design of the Oscillation Circuit

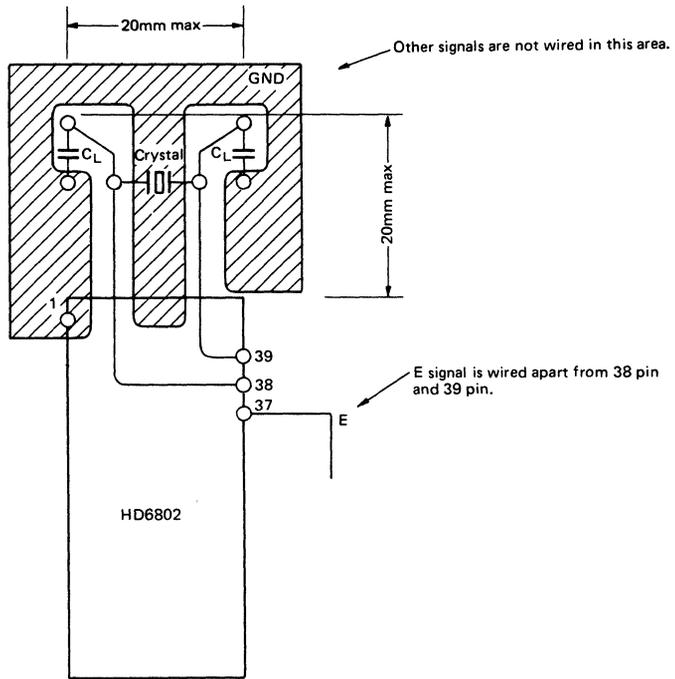


Figure 18 Example of Board Design Using the Crystal Oscillator

■ NOTE FOR THE RELATION BETWEEN WAI INSTRUCTION AND HALT OPERATION OF HD6802

When $\overline{\text{HALT}}$ input signal is asserted to "Low" level, the MPU will be halted after the execution of the current instruction except WAI instruction.

The "Halt" signal is not accepted after the fetch cycle of the WAI instruction (See ① in Fig. 19). In the case of the "WAI" instruction, the MPU enters the "WAIT" cycle after stacking the internal registers and

outputs the "High" level on the BA line.

When an interrupt request signal is input to the MPU, the MPU accepts the interrupt regardless the "Halt" signal and releases the "WAIT" state and outputs the interrupt's vector address. If the "Halt" signal is "Low" level, the MPU halts after the fetch of new PC contents. The sequence is shown below.

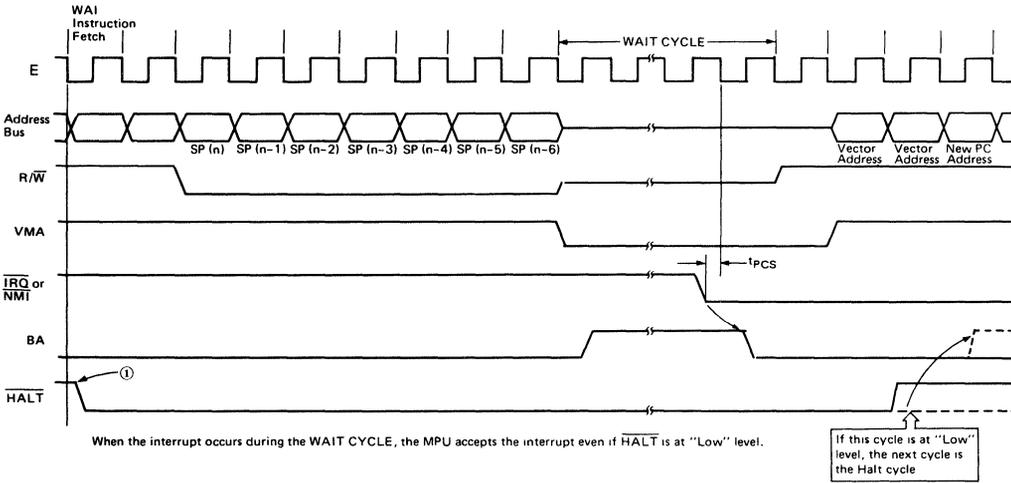


Figure 19 HD6802 WAIT CYCLE & $\overline{\text{HALT}}$ Request

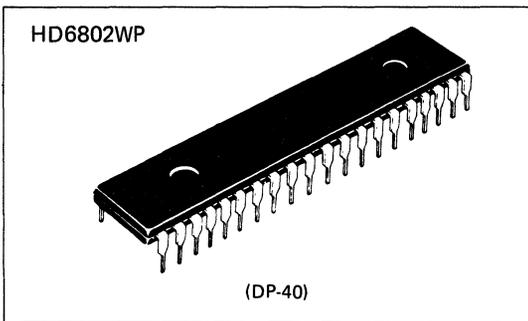
HD6802W

MPU (Microprocessor with Clock and RAM)

HD6802W is the enhanced version of HD6802 which contains MPU, clock and 256 bytes RAM. Internal RAM has been extended from 128 to 256 bytes to increase the capacity of system read/write memory for handling temporary data and manipulating the stack.

The internal RAM is located at hex addresses 0000 to 00FF. The first 32 bytes of RAM, at hex addresses 0000 to 001F, may be retained in a low power mode by utilizing V_{CC} standby, thus facilitating memory retention during a power-down situation.

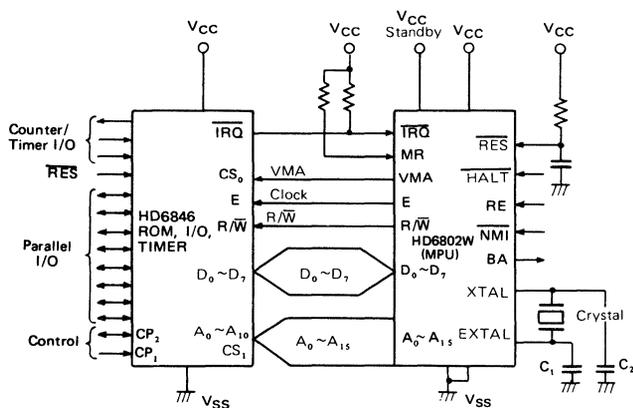
The HD6802W is completely software compatible with the HD6800 as well as the entire HMCS6800 family of parts. Hence, the HD6802W is expandable to 65k words.



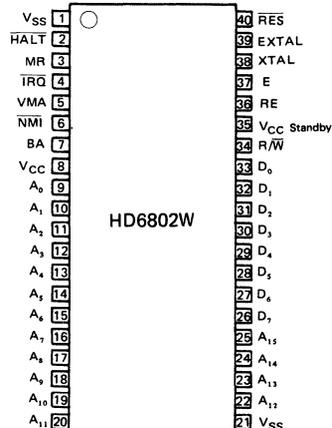
■ FEATURES

- On-Chip Clock Circuit
- 256 × 8 Bit On-Chip RAM
- 32 Bytes of RAM are Retainable
- Software-Compatible with the HD6800, HD6802
- Expandable to 65k words
- Standard TTL-Compatible Inputs and Outputs
- 8 Bit Word Size
- 16 Bit Memory Addressing
- Interrupt Capability

■ BLOCK DIAGRAM



■ PIN ARRANGEMENT



(Top View)

A expanded block diagram of the HD6802W is shown in Fig. 1. As shown, the number and configuration of the registers are

the same as the HD6802 except that the internal RAM has been extended to 256 bytes.

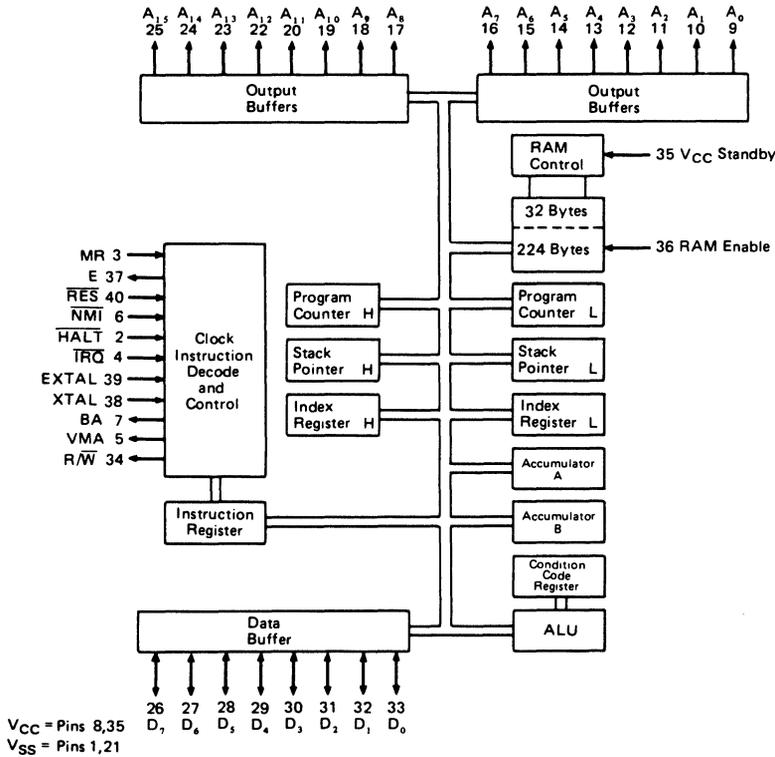


Figure 1 Expanded Block Diagram

Address Map of RAM is shown in Fig. 2.

The HD6802W has 256 bytes of RAM on the chip located at hex addresses 0000 to 00FF. The first 32 bytes of RAM, at hex addresses 0000 to 001F, may be retained in a low power

mode by utilizing V_{CC} standby and setting RAM Enable Signal "Low" level, thus facilitating memory retention during a power-down situation.

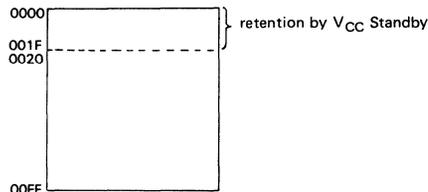


Figure 2 Address Map of HD6802W

■ ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Value	Unit
Supply Voltage	V_{CC}^* $V_{CC} \text{ Standby}^*$	-0.3 ~ +7.0	V
Input Voltage	V_{in}^*	-0.3 ~ +7.0	V
Operating Temperature	T_{opr}	-20 ~ +75	°C
Storage Temperature	T_{stg}	-55 ~ +150	°C

* With respect to V_{SS} (SYSTEM GND)

(NOTE) Permanent LSI damage may occur if maximum ratings are exceeded. Normal operation should be under recommended operating conditions. If these conditions are exceeded, it could affect reliability of LSI.

■ RECOMMENDED OPERATING CONDITIONS

Item	Symbol	min	typ	max	Unit	
Supply Voltage	V_{CC}^*	4.75	5.0	5.25	V	
	$V_{CC} \text{ Standby}^*$	4.0				
Input Voltage	V_{IL}^*	-0.3	-	0.8	V	
	V_{IH}^*	Except \overline{RES}	2.0	-	V_{CC}	V
		\overline{RES}	$V_{CC} - 0.75$	-	V_{CC}	
Operation Temperature	T_{opr}	-20	25	75	°C	

* With respect to V_{SS} (SYSTEM GND)

■ ELECTRICAL CHARACTERISTICS

● DC CHARACTERISTICS ($V_{CC}=5.0V\pm 5\%$, $V_{CC} \text{ Standby}=5.0V\pm 5\%$, $V_{SS}=0V$, $T_a=-20\sim+75^\circ C$, unless otherwise noted.)

Item	Symbol	Test Condition	min	typ*	max	Unit	
Input "High" Voltage	Except \overline{RES}	V_{IH}	2.0	-	V_{CC}	V	
	\overline{RES}		$V_{CC}-0.75$	-	V_{CC}		
Input "Low" Voltage	Except \overline{RES}	V_{IL}	-0.3	-	0.8	V	
	\overline{RES}		-0.3	-	0.8		
Output "High" Voltage	$D_0\sim D_7, E$	V_{OH}	$I_{OH} = -205\mu A$	2.4	-	-	V
	$A_0\sim A_{15}, R/\overline{W}, VMA$		$I_{OH} = -145\mu A$	2.4	-	-	
	BA		$I_{OH} = -100\mu A$	2.4	-	-	
Output "Low" Voltage		V_{OL}	$I_{OL} = 1.6mA$	-	-	0.4	V
Three State (Off State) Input Current	$D_0\sim D_7$	I_{TSI}	$V_{in} = 0.4\sim 2.4V$	-10	-	10	μA
Input Leakage Current	Except $D_0\sim D_7$	I_{in}^{***}	$V_{in} = 0\sim 5.25V$	-2.5	-	2.5	μA
Power Dissipation		P_D^{****}		-	0.7	1.2	W
Input Capacitance	$D_0\sim D_7$	C_{in}	$V_{in}=0V, T_a=25^\circ C,$ $f=1.0MHz$	-	10	12.5	pF
	Except $D_0\sim D_7$			-	6.5	10	
Output Capacitance	$A_0\sim A_{15}, R/\overline{W}, BA,$ VMA	C_{out}	$V_{in}=0V, T_a=25^\circ C,$ $f=1.0MHz$	-	-	12	pF

* $T_a=25^\circ C, V_{CC}=5V$

** As \overline{RES} input has hysteresis character, applied voltage up to 2.4V is regarded as "Low" level when it goes up from 0V.

*** Does not include EXTAL and XTAL, which are crystal inputs.

**** In power-down mode, maximum power dissipation is less than 42mW.

● AC CHARACTERISTICS ($V_{CC}=5.0V\pm 5\%$, $V_{CC\ Standby}=5.0V\pm 5\%$, $V_{SS}=0V$, $T_a=-20\sim+75^\circ C$, unless otherwise noted.)

1. CLOCK TIMING CHARACTERISTICS

Item	Symbol	Test Condition	min	typ	max	Unit		
Frequency of Operation	Input Clock $\div 4$	f	0.1	—	1.0	MHz		
	Crystal Frequency	f_{XTAL}	1.0	—	4.0			
Cycle Time	t_{cyc}	Fig. 4, Fig. 5	1.0	—	10	μs		
Clock Pulse Width	"High" Level	$PW_{\phi H}$	at 2.4V (Fig. 4, Fig. 5)		450	—	4500	ns
	"Low" Level	$PW_{\phi L}$	at 0.8V (Fig. 4, Fig. 5)					
Clock Fall Time	t_{ϕ}	0.8V \sim 2.4V (Fig. 4, Fig. 5)	—	—	25	ns		

2. READ/WRITE TIMING

Item	Symbol	Test Condition	min	typ*	max	Unit
Address Delay	t_{AD}	Fig. 4, Fig. 5, Fig. 8	—	—	270	ns
Peripheral Read Access Time	t_{acc}	Fig. 4	—	—	530	ns
Data Setup Time (Read)	t_{DSR}	Fig. 4	100	—	—	ns
Input Data Hold Time	t_H	Fig. 4	10	—	—	ns
Output Data Hold Time	t_H	Fig. 5	20	—	—	ns
Address Hold Time (Address, R/ \bar{W} , VMA)	t_{AH}	Fig. 4, Fig. 5	10	—	—	ns
Data Delay Time (Write)	t_{DDW}	Fig. 5	—	—	225	ns
Bus Available Delay	t_{BA}	Fig. 6, Fig. 7, Fig. 9, Fig. 10	—	—	250	ns
Processor Controls Processor Control Setup Time Processor Control Rise and Fall Time (Measured at 0.8V and 2.0V)	t_{PCS}	Fig. 6 \sim Fig. 9, Fig. 11	200	—	—	ns
	t_{PCr} , t_{PCf}	Fig. 6 \sim Fig. 9, Fig. 11, Fig. 12, Fig. 14	—	—	100	ns

* $T_a = 25^\circ C$, $V_{CC} = 5V$

3. POWER DOWN SEQUENCE TIMING, POWER UP RESET TIMING AND MEMORY READY TIMING

Item	Symbol	Test Condition	min	typ	max	Unit
RAM Enable Reset Time (1)	t_{RE1}	Fig. 12	150	—	—	ns
RAM Enable Reset Time (2)	t_{RE2}	Fig. 12	E-3 cycles	—	—	
Reset Release Time	t_{LRES}	Fig. 11	20	—	—	ms
RAM Enable Reset Time (3)	t_{RE3}	Fig. 11	0	—	—	ns
Memory Ready Setup Time	t_{SMR}	Fig. 14	300	—	—	ns
Memory Ready Hold Time	t_{HMR}	Fig. 14	0	—	200	ns

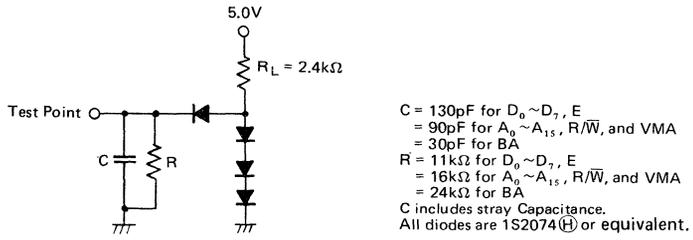


Figure 3 Bus Timing Test Load

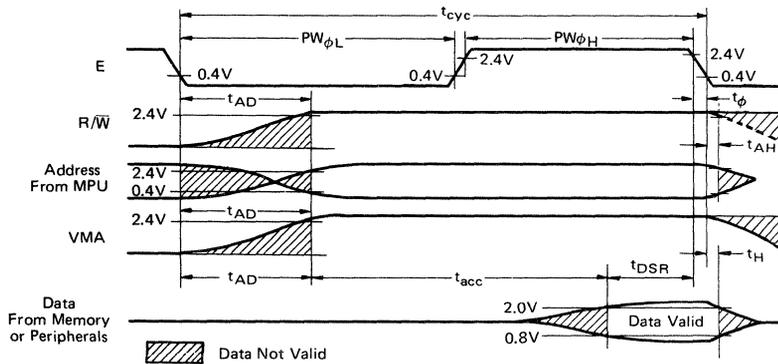


Figure 4 Read Data from Memory or Peripherals

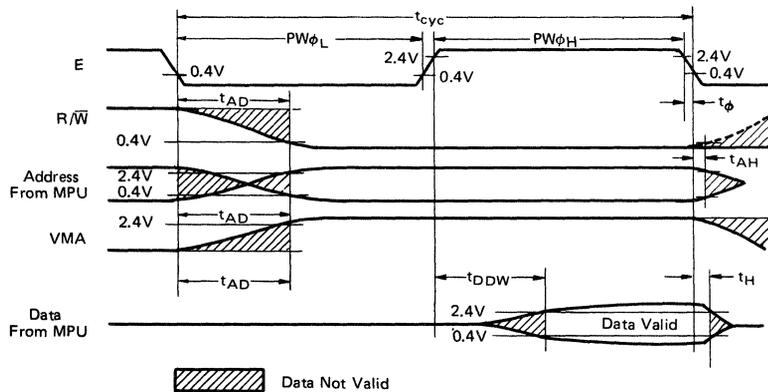


Figure 5 Write Data in Memory or Peripherals

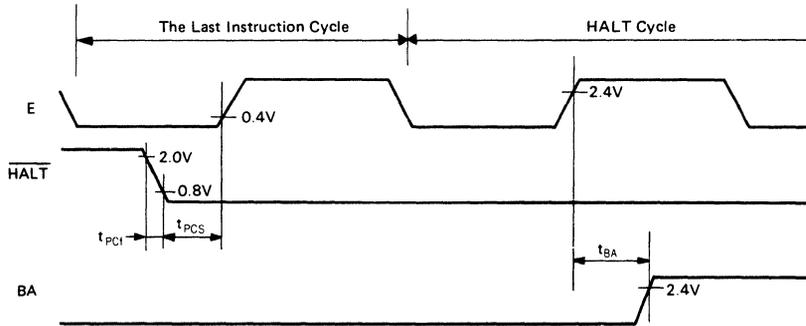


Figure 6 Timing of $\overline{\text{HALT}}$ and BA

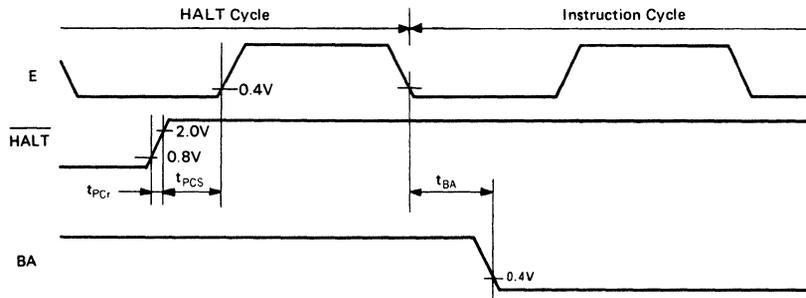


Figure 7 Timing of $\overline{\text{HALT}}$ and BA

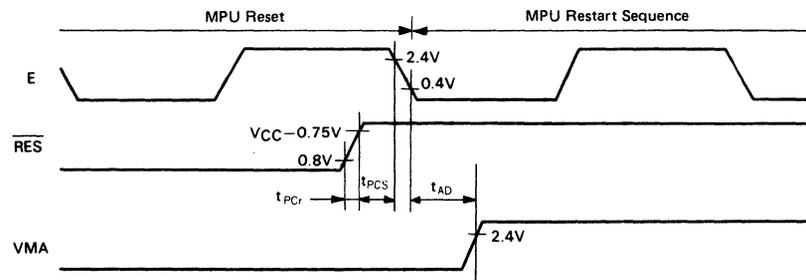


Figure 8 $\overline{\text{RES}}$ and MPU Restart Sequence

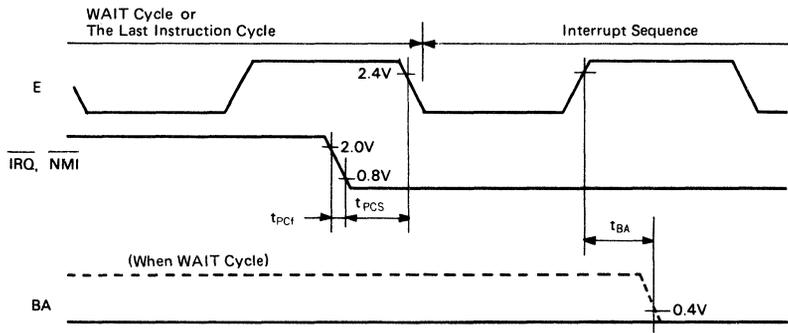


Figure 9 \overline{IRQ} and \overline{NMI} Interrupt Timing

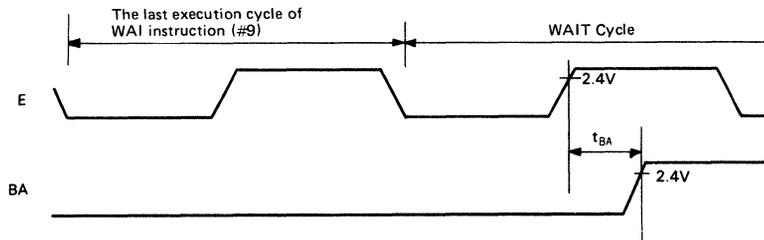


Figure 10 WAI Instruction and BA Timing

■ HD6802W MPU SIGNAL DESCRIPTION

● Address Bus ($A_0 \sim A_{15}$)

Sixteen pins are used for the address bus. The outputs are capable of driving one standard TTL load and 90pF.

● Data Bus ($D_0 \sim D_7$)

Eight pins are used for the data bus. It is bidirectional, transferring data to and from the memory and peripheral devices. It also has three-state output buffers capable of driving one standard TTL load and 130pF.

Data Bus will be in the output mode when the internal RAM is accessed. This prohibits external data entering the MPU. It should be noted that the internal RAM is fully decoded from \$0000 to \$00FF. External RAM at \$0000 to \$00FF must be disabled when internal RAM is accessed.

● HALT

When this input is in the "Low" state, all activity in the machine will be halted: This input is level sensitive.

In the halt mode, the machine will stop at the end of an instruction. Bus Available will be at a "High" state. Valid Memory Address will be at a "Low" state. The address bus will display the address of the next instruction.

To insure single instruction operation, transition of the $\overline{\text{HALT}}$ line must not occur during the last t_{PC} of E and the $\overline{\text{HALT}}$ line must go "High" for one Clock cycle.

$\overline{\text{HALT}}$ should be tied "High" if not used. This is good engineering design practice in general and necessary to insure proper operation of the part.

● Read/Write (R/\overline{W})

This TTL compatible output signals the peripherals and memory devices whether the MPU is in a Read ("High") or Write ("Low") state. The normal standby state of this signal is Read ("High"). When the processor is halted, it will be in the logical one state ("High").

This output is capable of driving one standard TTL load and 90pF.

● Valid Memory Address (VMA)

This output indicates to peripheral devices that there is a valid address on the address bus. In normal operation, this signal should be utilized for enabling peripheral interfaces such as the PIA and ACIA. This signal is not three-state. One standard TTL load and 90pF may be directly driven by this active high signal.

● Bus Available (BA)

The Bus Available signal will normally be in the "Low" state. When activated, it will go to the "High" state indicating that the microprocessor has stopped and that the address bus is available (but not in a three-state condition). This will occur if the $\overline{\text{HALT}}$ line is in the "Low" state or the processor is in the wait state as a result of the execution of a WAI instruction. At such time, all three-state output drivers will go to their off state and other outputs to their normally inactive level.

The processor is removed from the wait state by the occurrence of a maskable (mask bit I=0) or nonmaskable interrupt. This output is capable of driving one standard TTL load and 30pF.

● Interrupt Request ($\overline{\text{IRQ}}$)

This level sensitive input requests that an interrupt sequence

be generated within the machine. The processor will wait, until it completes the current instruction that is being executed before it recognizes the request. At that time, if the interrupt mask bit in the Condition Code Register is not set, the machine will begin an interrupt sequence. The Index Register, Program Counter, Accumulators, and Condition Code Register are stored away on the stack. Next the MPU will respond to the interrupt request by setting the interrupt mask bit high so that no further interrupts may occur. At the end of the cycle, a 16-bit address will be loaded that points to a vectoring address which is located in memory locations FFF8 and FFF9. An address loaded at these locations causes the MPU to branch to an interrupt routine in memory.

The $\overline{\text{HALT}}$ line must be in the "High" state for interrupts to be serviced. Interrupts will be latched internally while $\overline{\text{HALT}}$ is "Low".

A $3\text{k}\Omega$ external resistor to V_{CC} should be used for wire-OR and optimum control of interrupts.

● Reset ($\overline{\text{RES}}$)

This input is used to reset and start the MPU from a power-down condition, resulting from a power failure or an initial start-up of the processor. When this line is "Low", the MPU is inactive and the information in the registers will be lost. If a "High" level is detected on the input, this will signal the MPU to begin the restart sequence. This will start execution of a routine to initialize the processor from its reset condition. All the higher order address lines will be forced "High". For the restart, the last two (FFFE, FFFF) locations in memory will be used to load the program that is addressed by the program counter. During the restart routine, the interrupt mask bit is set and must be reset before the MPU can be interrupted by $\overline{\text{IRQ}}$. Power-up and reset timing and power-down sequences are shown in Fig. 11 and Fig. 12 respectively.

● Non-Maskable Interrupt ($\overline{\text{NMI}}$)

A low-going edge on this input requests that a non-mask-interrupt sequence be generated within the processor. As with the $\overline{\text{IRQ}}$ signal, the processor will complete the current instruction that is being executed before it recognizes the $\overline{\text{NMI}}$ signal. The interrupt mask bit in the Condition Code Register has no effect on $\overline{\text{NMI}}$.

The Index Register, Program Counter, Accumulators, and Condition Code Register are stored away on the stack. At the end of the cycle, a 16-bit address will be loaded that points to a vectoring address which is located in memory locations FFFC and FFFD. An address loaded at these locations causes the MPU to branch to a non-maskable interrupt routine in memory. A $3\text{k}\Omega$ external resistor to V_{CC} should be used for wire-OR and optimum control of interrupts.

Inputs $\overline{\text{IRQ}}$ and $\overline{\text{NMI}}$ are hardware interrupt lines that are sampled when E is "High" and will start the interrupt routine on a "Low" E following the completion of an instruction. $\overline{\text{IRQ}}$ and $\overline{\text{NMI}}$ should be tied "High" if not used. This is good engineering design practice in general and necessary to insure proper operation of the part. Fig. 13 is a flowchart describing the major decision paths and interrupt vectors of the microprocessor. Table 1 gives the memory map for interrupt vectors.

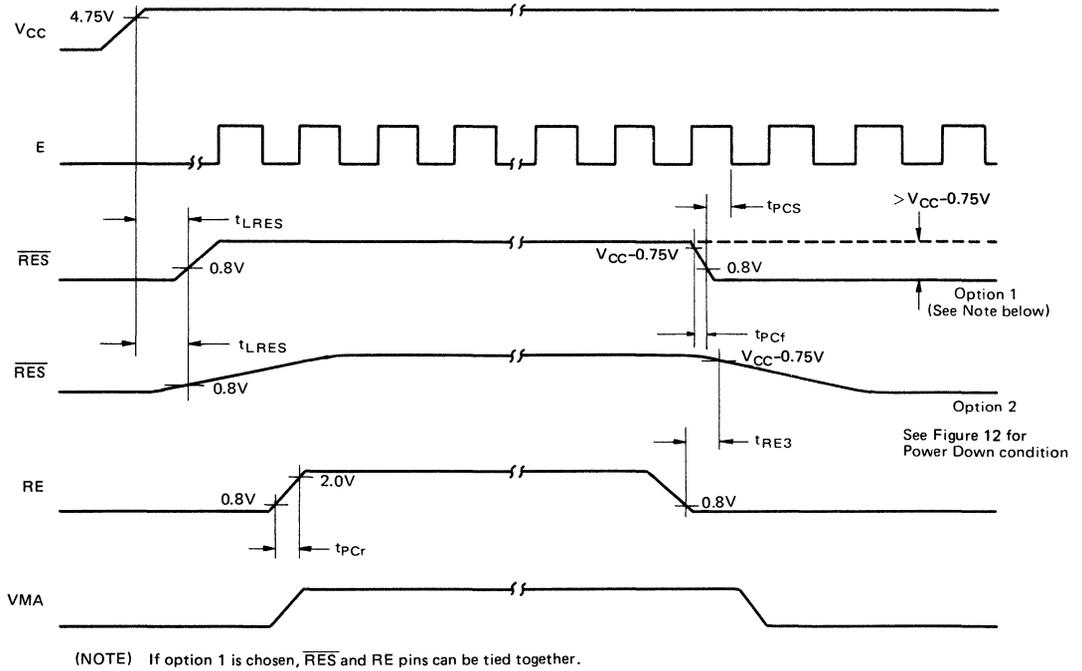


Figure 11 Power-up and Reset Timing

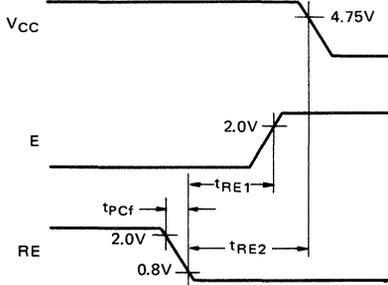


Figure 12 Power-down Sequence

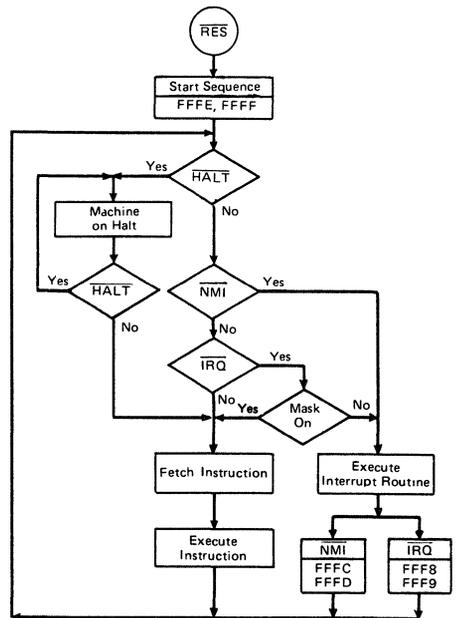


Figure 13 MPU Flow Chart

Table 1 Memory Map for Interrupt Vectors

Vector		Description
MS	LS	
FFFE	FFFF	Restart (RES)
FFFC	FFFD	Non-Maskable Interrupt (NMI)
FFFA	FFFB	Software Interrupt (SWI)
FFF8	FFF9	Interrupt Request (IRQ)

● **RAM Enable (RE)**

A TTL-compatible RAM enable input controls the on-chip RAM of the HD6802W. When placed in the "High" state, the on-chip memory is enabled to respond to the MPU controls. In the "Low" state, RAM is disabled. This pin may also be utilized to disable reading and writing the on-chip RAM during a power-down situation. RAM enable must be "Low" three cycles before V_{CC} goes below 4.75V during power-down.

RE should be tied to the correct "High" or "Low" state if not used. This is good engineering design practice in general and necessary to insure proper operation of the part.

● **EXTAL and XTAL**

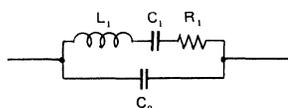
The HD6802W has an internal oscillator that may be crystal controlled. These connections are for a parallel resonant fundamental crystal (AT cut). A divide-by-four circuit has been added to the HD6802W so that a 4MHz crystal may be used in lieu of a 1MHz crystal for a more cost-effective system. Pin39 of the HD6802W may be driven externally by a TTL input signal if a separate clock is required. Pin38 is to be left open in this mode.

An RC network is not directly usable as a frequency source on pins 38 and 39. An RC network type TTL or CMOS oscillator will work well as long as the TTL or CMOS output drives the HD6802W.

If an external clock is used, it may not be halted for more than 4.5μs. The HD6802W is a dynamic part except for the internal RAM, and requires the external clock to retain information.

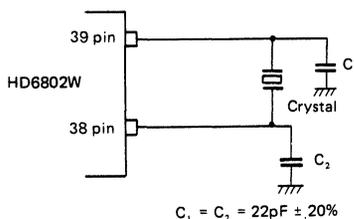
Conditions for Crystal (4 MHz)

- AT Cut Parallel resonant
- $C_0 = 7 \text{ pF max.}$
- $R_1 = 80 \Omega \text{ max.}$



Crystal Equivalent Circuit

Recommended Oscillator (4MHz)



When using the crystal, see the note for Board Design of the Oscillation Circuit in HD6802W.

● **Memory Ready (MR)**

MR is a TTL compatible input control signal which allows stretching of E. When MR is "High", E will be in normal operation. When MR is "Low", E may be stretched integral multiples of half periods, thus allowing interface to slow memories. Memory Ready timing is shown in Fig. 14.

MR should be tied "High" if not used. This is good engineering design practice in general and necessary to insure proper operation of the part. A maximum stretch is 4.5μs.

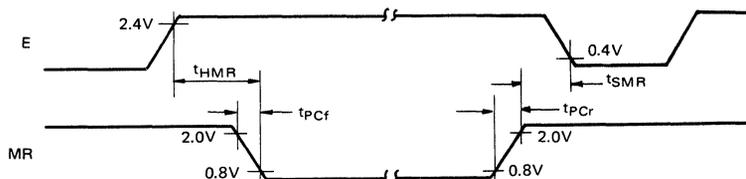


Figure 14 Memory Ready Control Function

● Enable (E)

This pin supplies the clock for the MPU and the rest of the system. This is a single phase, TTL compatible clock. This clock may be conditioned by a Memory Ready Signal. This is equivalent to ϕ_2 on the HD6800.

● V_{CC} Standby

This pin supplies the dc voltage to the first 32 bytes of RAM as well as the RAM Enable (RE) control logic. Thus retention of data in this portion of the RAM on a power-up, power-down, or standby condition is guaranteed at the range of 4.0 V to 5.25 V. Maximum current drain at 5.25V is 8mA.

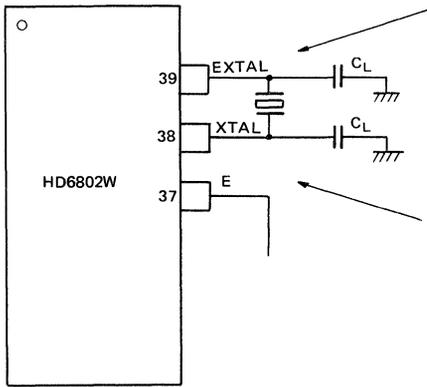
■ MPU INSTRUCTION SET

The HD6802W has a set of 72 different instructions. Included are binary and decimal arithmetic, logical, shift, rotate, load, store, conditional or unconditional branch, interrupt and stack manipulation instructions.

This instruction set is the same as that for the 6800MPU (HD6800 etc.) and is not explained again in this data sheet.

■ NOTE FOR BOARD DESIGN OF THE OSCILLATION CIRCUIT IN HD6802W

In designing the board, the following notes should be taken when the crystal oscillator is used.

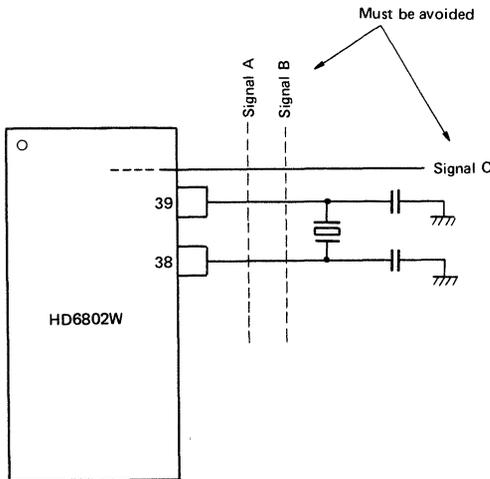


Crystal oscillator and load capacity C_L must be placed near the LSI as much as possible.

(Normal oscillation may be disturbed when external noise is induced to pin 38 and 39.)

Pin 38 signal line should be wired apart from pin 37 signal line as much as possible. Don't wire them in parallel, or normal oscillation may be disturbed when E signal is feedbacked to XTAL.

The following design must be avoided.



A signal line or a power source line must not cross or go near the oscillation circuit line as shown in the left figure to prevent the induction from these lines and perform the correct oscillation. The resistance among XTAL, EXTAL and other pins should be over 10M Ω .

Figure 15 Note for Board Design of the Oscillation Circuit

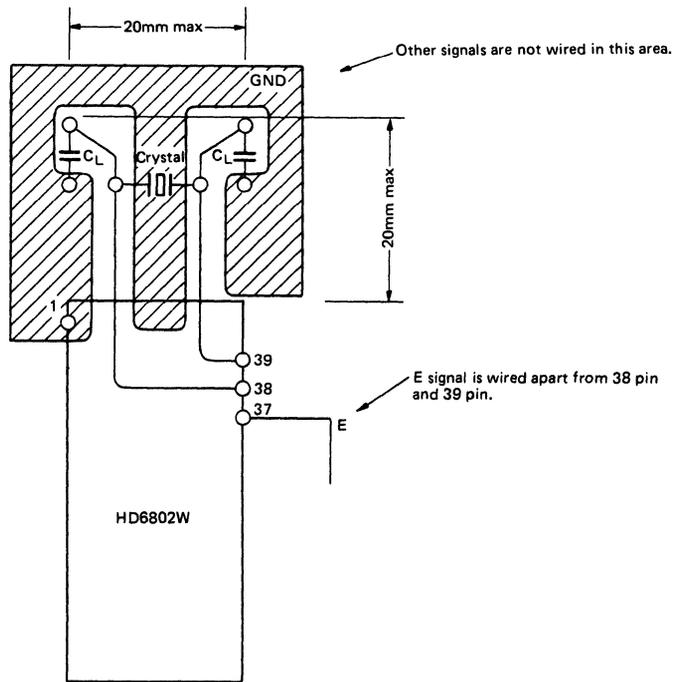


Figure 16 Example of Board Design Using the Crystal Oscillator

■ NOTE FOR THE RELATION BETWEEN WAI INSTRUCTION AND HALT OPERATION OF HD6802W

When $\overline{\text{HALT}}$ input signal is asserted to "Low" level, the MPU will be halted after the execution of the current instruction except WAI instruction.

The "Halt" signal is not accepted after the fetch cycle of the WAI instruction (See ① in Fig. 17). In the case of the "WAI" instruction, the MPU enters the "WAIT" cycle after stacking the internal registers and

outputs the "High" level on the BA line.

When an interrupt request signal is input to the MPU, the MPU accepts the interrupt regardless the "Halt" signal and releases the "WAIT" state and outputs the interrupt's vector address. If the "Halt" signal is "Low" level, the MPU halts after the fetch of new PC contents. The sequence is shown below.

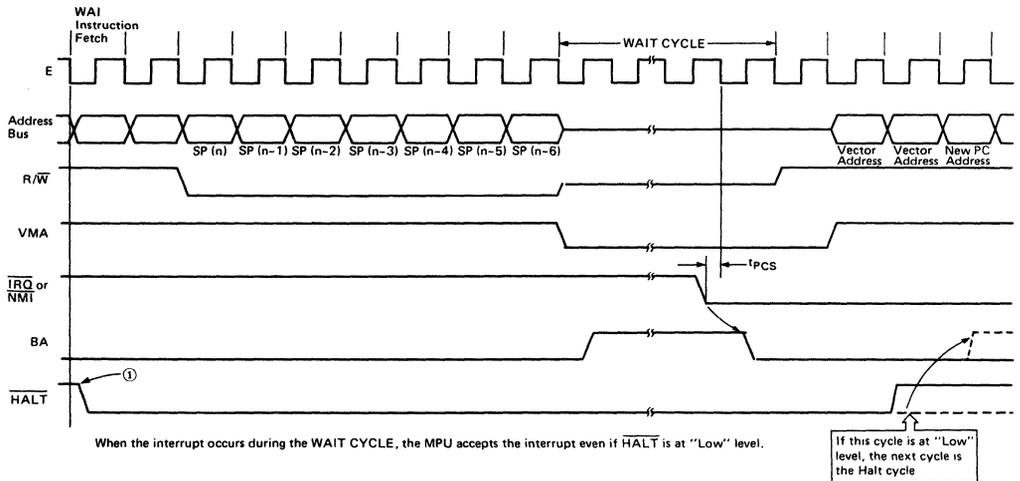


Figure 17 HD6802W WAIT CYCLE & $\overline{\text{HALT}}$ Request

HD6809, HD68A09, HD68B09

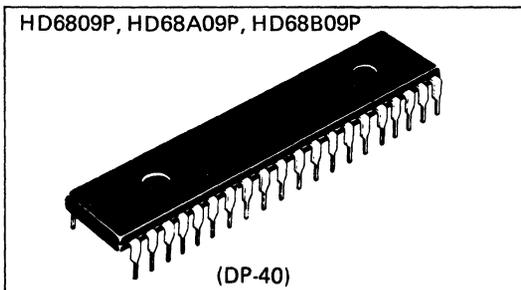
MPU (Micro Processing Unit)

The HD6809 is a revolutionary high performance 8-bit microprocessor which supports modern programming techniques such as position independence, reentrancy, and modular programming.

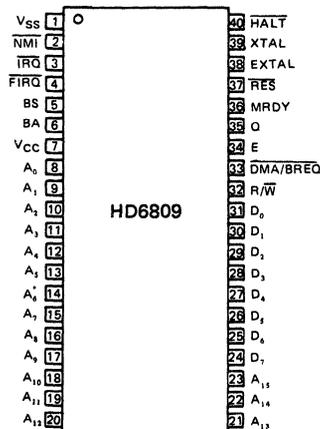
This third-generation addition to the HMCS6800 family has major architectural improvements which include additional registers, instructions and addressing modes.

The basic instructions of any computer are greatly enhanced by the presence of powerful addressing modes. The HD6809 has the most complete set of addressing modes available on any 8-bit microprocessor today.

The HD6809 has hardware and software features which make it an ideal processor for higher level language execution or standard controller applications.



■ PIN ARRANGEMENT



(Top View)

HD6800 COMPATIBLE

- Hardware — Interfaces with All HMCS6800 Peripherals
- Software — Upward Source Code Compatible Instruction Set and Addressing Modes

■ ARCHITECTURAL FEATURES

- Two 16-bit Index Registers
- Two 16-bit Indexable Stack Pointers
- Two 8-bit Accumulators can be Concatenated to Form One 16-Bit Accumulator
- Direct Page Register Allows Direct Addressing Throughout Memory

■ HARDWARE FEATURES

- On Chip Oscillator
- DMA/BREQ Allows DMA Operation or Memory Refresh
- Fast Interrupt Request Input Stacks Only Condition Code Register and Program Counter
- MRDY Input Extends Data Access Times for Use With Slow Memory
- Interrupt Acknowledge Output Allows Vectoring By Devices
- SYNC Acknowledge Output Allows for Synchronization to External Event
- Single Bus-Cycle RESET
- Single 5-Volt Supply Operation
- NMI Blocked After RESET Until After First Load of Stack Pointer
- Early Address Valid Allows Use With Slower Memories
- Early Write-Data for Dynamic Memories
- Compatible with MC6809, MC68A09 and MC68B09

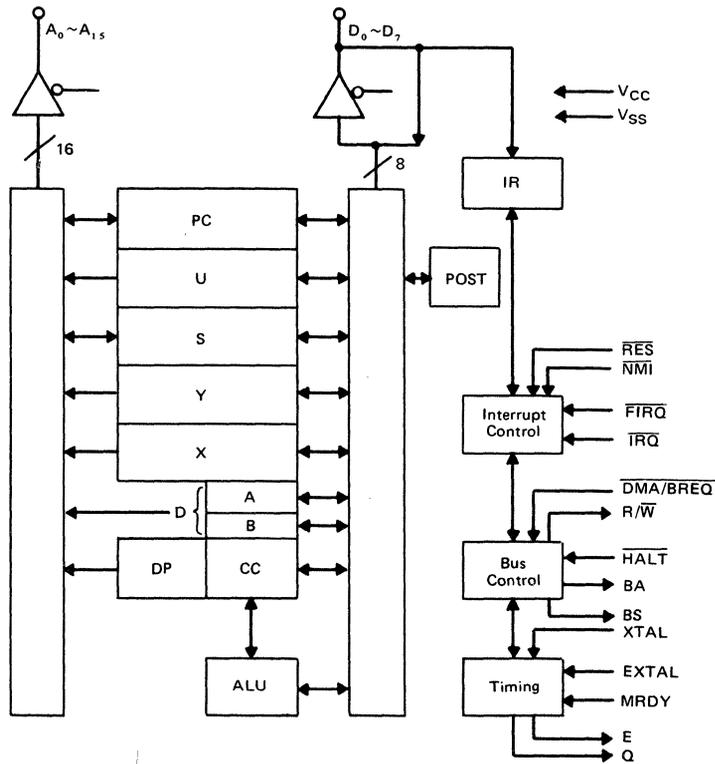
■ SOFTWARE FEATURES

- 10 Addressing Modes
 - HMCS6800 Upward Compatible Addressing Modes
 - Direct Addressing Anywhere in Memory Map
 - Long Relative Branches
 - Program Counter Relative
 - True Indirect Addressing
 - Expanded Indexed Addressing:

- 0, 5, 8, or 16-bit Constant Offsets
- 8, or 16-bit Accumulator Offsets
- Auto-Increment/Decrement by 1 or 2

- Improved Stack Manipulation
- 1464 Instructions with Unique Addressing Modes
- 8 x 8 Unsigned Multiply
- 16-bit Arithmetic
- Transfer/Exchange All Registers
- Push/Pull Any Registers or Any Set of Registers
- Load Effective Address

■ BLOCK DIAGRAM



■ ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Value	Unit
Supply Voltage	V _{CC} *	-0.3 ~ +7.0	V
Input Voltage	V _{in} *	-0.3 ~ +7.0	V
Operating Temperature	T _{opr}	-20 ~ +75	°C
Storage Temperature	T _{stg}	-55 ~ +150	°C

* With respect to V_{SS} (SYSTEM GND)

(NOTE) Permanent LSI damage may occur if maximum ratings are exceeded. Normal operation should be under recommended operating conditions. If these conditions are exceeded, it could affect reliability of LSI.

■ RECOMMENDED OPERATING CONDITIONS

Item	Symbol	min	typ	max	Unit	
Supply Voltage	V _{CC} *	4.75	5.0	5.25	V	
	V _{IL} *	-0.3	-	0.8	V	
Input Voltage	V _{IH} *	Logic (Ta = 0 ~ +75°C)	2.0	-	V _{CC}	V
		Logic (Ta = -20 ~ 0°C)	2.2	-	V _{CC}	
		RES	4.0	-	V _{CC}	
Operating Temperature	T _{opr}	-20	25	75	°C	

* With respect to V_{SS} (SYSTEM GND)

■ ELECTRICAL CHARACTERISTICS

● DC CHARACTERISTICS (V_{CC}=5V±5%, V_{SS}=0V, Ta = -20~+75°C, unless otherwise noted.)

Item	Symbol	Test Condition	HD6809			HD68A09			HD68B09			Unit	
			min	typ*	max	min	typ*	max	min	typ*	max		
Input "High" Voltage	Except RES	V _{IH}	Ta = 0 ~ +75°C	2.0	-	V _{CC}	2.0	-	V _{CC}	2.0	-	V _{CC}	V
			Ta = -20 ~ 0°C	2.2	-	V _{CC}	2.2	-	V _{CC}	2.2	-	V _{CC}	
	RES	4.0	-	V _{CC}	4.0	-	V _{CC}	4.0	-	V _{CC}			
Input "Low" Voltage	V _{IL}		-0.3	-	0.8	-0.3	-	0.8	-0.3	-	0.8	V	
Input Leakage Current	I _{in}	Except EXTERNAL XTAL	Vin=0~5.25V, V _{CC} =max	-2.5	-	2.5	-2.5	-	2.5	-2.5	-	2.5	μA
Three State (Off State) Input Current	I _{TSI}	D ₀ ~D ₇	Vin=0.4~2.4V, V _{CC} =max	-10	-	10	-10	-	10	-10	-	10	μA
		A ₀ ~A ₁₅ , R/W	Vin=0.4~2.4V, V _{CC} =max	-100	-	100	-100	-	100	-100	-	100	
Output "High" Voltage	V _{OH}	D ₀ ~D ₇	I _{LOAD} =-205μA, V _{CC} =min	2.4	-	-	2.4	-	-	2.4	-	-	V
		A ₀ ~A ₁₅ , R/W, Q, E	I _{LOAD} =-145μA, V _{CC} =min	2.4	-	-	2.4	-	-	2.4	-	-	
		BA, BS	I _{LOAD} =-100μA, V _{CC} =min	2.4	-	-	2.4	-	-	2.4	-	-	
Output "Low" Voltage	V _{OL}	I _{LOAD} =2mA	-	-	0.5	-	-	0.5	-	-	0.5	V	
Power Dissipation	P _D		-	-	1.0	-	-	1.0	-	-	1.0	W	
Input Capacitance	C _{in}	D ₀ ~D ₇	Vin=0V, Ta=25°C, f=1MHz	-	10	15	-	10	15	-	10	15	pF
		Except D ₀ ~D ₇	Vin=0V, Ta=25°C, f=1MHz	-	7	10	-	7	10	-	7	10	
Output Capacitance	C _{out}	A ₀ ~A ₁₅ , R/W, BA, BS	Vin=0V, Ta=25°C, f=1MHz	-	-	12	-	-	12	-	-	12	pF

*Ta=25°C, V_{CC}=5V

● AC CHARACTERISTICS (V_{CC}=5V±5%, V_{SS} = 0V, T_a = -20~+75°C, unless otherwise noted.)

1. CLOCK TIMING

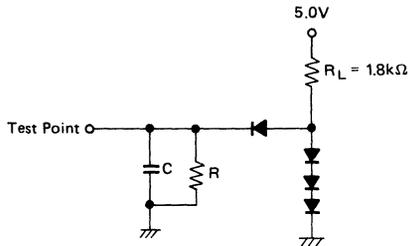
Item	Symbol	Test Condition	HD6809			HD68A09			HD68B09			Unit
			min	typ	max	min	typ	max	min	typ	max	
Frequency of Operation (Crystal or External Input)	f _{XTAL}	Fig. 2, Fig. 3	0.4	—	4	0.4	—	6	0.4	—	8	MHz
Cycle Time	t _{cyc}		1000	—	10000	667	—	10000	500	—	10000	ns
Total Up Time	t _{UT}		975	—	—	640	—	—	480	—	—	ns
Processor Clock "High"	t _{PWEH}		450	—	15500	280	—	15700	220	—	15700	ns
Processor Clock "Low"	t _{PWEL}		430	—	5000	280	—	5000	210	—	5000	ns
E Rise and Fall Time	t _{Er} , t _{Ef}		—	—	25	—	—	25	—	—	20	ns
E _{Low} to Q _{High} Time	t _{AVS}		200	—	250	130	—	165	80	—	125	ns
Q Clock "High"	t _{PWQH}		450	—	5000	280	—	5000	220	—	5000	ns
Q Clock "Low"	t _{PWQL}		450	—	15500	280	—	15700	220	—	15700	ns
Q Rise and Fall Time	t _{Qr} , t _{Qf}		—	—	25	—	—	25	—	—	20	ns
Q _{Low} to E Falling	t _{QE}		200	—	—	133	—	—	100	—	—	ns

2. BUS TIMING

Item	Symbol	Test Condition	HD6809			HD68A09			HD68B09			Unit
			min	typ	max	min	typ	max	min	typ	max	
Address Delay	t _{AD}	Fig. 2, Fig. 3	—	—	200	—	—	140	—	—	110	ns
Address Valid to Q _{High}	t _{AQ}		50	—	—	25	—	—	15	—	—	ns
Peripheral Read Access Time (t _{UT} -t _{AD} -t _{DSR} -t _{ACC})	t _{ACC}		695	—	—	440	—	—	330	—	—	ns
Data Set Up Time (Read)	t _{DSR}		80	—	—	60	—	—	40	—	—	ns
Input Data Hold Time	t _{DHR}		10	—	—	10	—	—	10	—	—	ns
Address Hold Time	A ₀ ~A ₁₁ , R/ \bar{W}		t _{AH}	20	—	—	20	—	—	20	—	—
		Fig. 2, Fig. 3 T _a =-20~0°C	10	—	—	10	—	—	10	—	—	ns
Data Delay Time (Write)	t _{DDW}	Fig. 3	—	—	200	—	—	140	—	—	110	ns
Output Hold Time	t _{DHW}	Fig. 3 T _a =0~+75°C	30	—	—	30	—	—	30	—	—	ns
		Fig. 3 T _a =-20~0°C	20	—	—	20	—	—	20	—	—	ns

3. PROCESSOR CONTROL TIMING

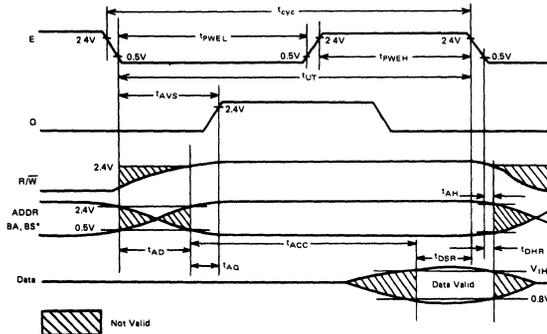
Item	Symbol	Test Condition	HD6809			HD68A09			HD68B09			Unit
			min	typ	max	min	typ	max	min	typ	max	
MRDY Set Up Time	t _{PCSM}	Fig. 6~Fig. 10 Fig. 14, Fig. 15	125	—	—	125	—	—	110	—	—	ns
Interrupts Set Up Time	t _{PCS}		200	—	—	140	—	—	110	—	—	ns
HALT Set Up Time	t _{PCSH}		200	—	—	140	—	—	110	—	—	ns
RES Set Up Time	t _{PCSR}		200	—	—	140	—	—	110	—	—	ns
DMA/BREQ Set Up Time	t _{PCSD}		125	—	—	125	—	—	110	—	—	ns
Processor Control Rise and Fall Time	t _{PCr} , t _{PCf}		—	—	100	—	—	100	—	—	100	ns
Crystal Oscillator Start Time	t _{RC}	—	—	50	—	—	30	—	—	30	ms	



- C = 30pF (BA, BS)
130pF (D₀ ~ D₇, E, Q)
- R = 11kΩ (A₀ ~ A₁₅, R/W)
16kΩ (A₀ ~ A₁₅, E, Q, R/W)
24kΩ (BA, BS)

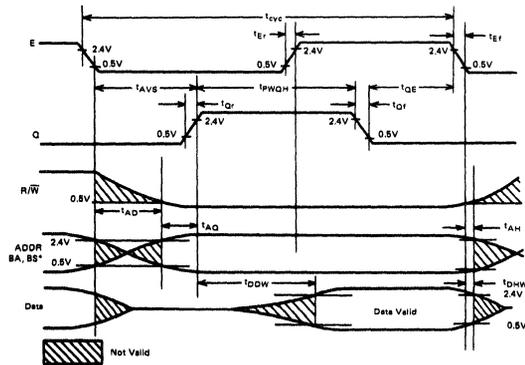
All diodes are 1S2074 or equivalent.
C includes Stray Capacitance.

Figure 1 Bus Timing Test Load



*Hold time for BA, BS not specified.

Figure 2 Read Data from Memory or Peripherals



*Hold time for BA, BS not specified.

Figure 3 Write Data to Memory or Peripherals

PROGRAMMING MODEL

As shown in Figure 4, the HD6809 adds three registers to the set available in the HD6800. The added registers include a Direct Page Register, the User Stack pointer and a second Index Register.

Accumulators (A, B, D)

The A and B registers are general purpose accumulators which are used for arithmetic calculations and manipulation of data.

Certain instructions concatenate the A and B registers to form a single 16-bit accumulator. This is referred to as the D

register, and is formed with the A register as the most significant byte.

Direct Page Register (DP)

The Direct Page Register of the HD6809 serves to enhance the Direct Addressing Mode. The content of this register appears at the higher address outputs (A₈ ~ A₁₅) during Direct Addressing Instruction execution. This allows the direct mode to be used at any place in memory, under program control. To ensure HD6800 compatibility, all bits of this register are cleared during Processor Reset.

● **Index Registers (X, Y)**

The Index Registers are used in indexed mode of addressing. The 16-bit address in this register takes part in the calculation of effective addresses. This address may be used to point to data directly or may be modified by an optional constant or register

offset. During some indexed modes, the contents of the index register are incremented or decremented to point to the next item of tabular type data. All four pointer registers (X, Y, U, S) may be used as index registers.

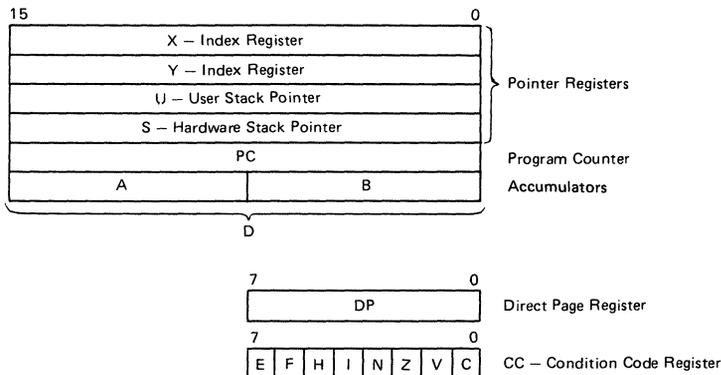


Figure 4 Programming Model of The Microprocessing Unit

● **Stack Pointer (U, S)**

The Hardware Stack Pointer (S) is used automatically by the processor during subroutine calls and interrupts. The stack pointers of the HD6809 point to the top of the stack, in contrast to the HD6800 stack pointer, which pointed to the next free location on the stack. The User Stack Pointer (U) is controlled exclusively by the programmer thus allowing arguments to be passed to and from subroutines with ease. Both Stack Pointers have the same indexed mode addressing capabilities as the X and Y registers, but also support Push and Pull instructions. This allows the HD6809 to be used efficiently as a stack processor, greatly enhancing its ability to support higher level languages and modular programming.

● **Program Counter**

The Program Counter is used by the processor to point to the address of the next instruction to be executed by the processor. Relative Addressing is provided allowing the Program Counter to be used like an index register in some situations.

● **Condition Code Register**

The Condition Code Register defines the State of the Processor at any given time. See Fig. 5.

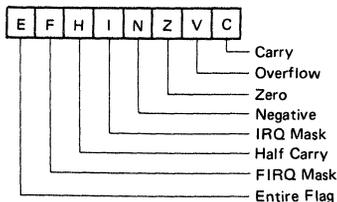


Figure 5 Condition Code Register Format

■ **CONDITION CODE REGISTER DESCRIPTION**

● **Bit 0 (C)**

Bit 0 is the carry flag, and is usually the carry from the binary ALU. C is also used to represent a 'borrow' from subtract like instructions (CMP, NEG, SUB, SBC) and is the complement of the carry from the binary ALU.

● **Bit 1 (V)**

Bit 1 is the overflow flag, and is set to a one by an operation which causes a signed two's complement arithmetic overflow. This overflow is detected in an operation in which the carry from the MSB in the ALU does not match the carry from the MSB-1.

● **Bit 2 (Z)**

Bit 2 is the zero flag, and is set to a one if the result of the previous operation was identically zero.

● **Bit 3 (N)**

Bit 3 is the negative flag, which contains exactly the value of the MSB of the result of the preceding operation. Thus, a negative two's-complement result will leave N set to a one.

● **Bit 4 (I)**

Bit 4 is the \overline{IRQ} mask bit. The processor will not recognize interrupts from the \overline{IRQ} line if this bit is set to a one. \overline{NMI} , \overline{FIRQ} , \overline{IRQ} , \overline{RES} , and \overline{SWI} all are set I to a one; $\overline{SWI2}$ and $\overline{SWI3}$ do not affect I.

● **Bit 5 (H)**

Bit 5 is the half-carry bit, and is used to indicate a carry from bit 3 in the ALU as a result of an 8-bit addition only (ADC or ADD). This bit is used by the DAA instruction to perform a BCD decimal add adjust operation. The state of this flag is

undefined in all subtract-like instructions.

● **Bit 6 (F)**

Bit 6 is the $\overline{\text{FIRQ}}$ mask bit. The processor will not recognize interrupts from the $\overline{\text{FIRQ}}$ line if this bit is a one. $\overline{\text{NMI}}$, $\overline{\text{FIRQ}}$, $\overline{\text{SWI}}$, and $\overline{\text{RES}}$ all set F to a one. $\overline{\text{IRQ}}$, $\overline{\text{SWI2}}$ and $\overline{\text{SWI3}}$ do not affect F.

● **Bit 7 (E)**

Bit 7 is the entire flag, and when set to a one indicates that the complete machine state (all the registers) was stacked, as opposed to the subset state (PC and CC). The E bit of the stacked CC is used on a return from interrupt (RTI) to determine the extent of the unstacking. Therefore, the current E left in the Condition Code Register represents past action.

■ **SIGNAL DESCRIPTION**

● **Power (V_{SS}, V_{CC})**

Two pins are used to supply power to the part: V_{SS} is ground or 0 volts, while V_{CC} is +5.0V ±5%.

● **Address Bus (A₀~A₁₅)**

Sixteen pins are used to output address information from the MPU onto the Address Bus. When the processor does not require the bus for a data transfer, it will output address FFFF_{16} , $\overline{\text{R}/\overline{\text{W}}} = \text{"High"}$, and $\text{BS} = \text{"Low"}$; this is a "dummy access" or $\overline{\text{VMA}}$ cycle. Addresses are valid on the rising edge of Q (see Figs. 2 and 3). All address bus drivers are made high impedance when output Bus Available (BA) is "High". Each pin will drive one Schottky TTL load or four LS TTL loads, and typically 90 pF.

● **Data Bus (D₀~D₇)**

These eight pins provide communication with the system bi-directional data bus. Each pin will drive one Schottky TTL load or four LS TTL loads, and typically 130 pF.

● **Read/Write (R/ $\overline{\text{W}}$)**

This signal indicates the direction of data transfer on the data bus. A "Low" indicates that the MPU is writing data onto the data bus. $\overline{\text{R}/\overline{\text{W}}}$ is made high impedance when BA is "High". $\overline{\text{R}/\overline{\text{W}}}$ is valid on the rising edge of Q. Refer to Figs. 2 and 3.

● **Reset ($\overline{\text{RES}}$)**

A "Low" level on this Schmitt-trigger input for greater than one bus cycle will reset the MPU, as shown in Fig. 6. The Reset vectors are fetched from locations FFFE_{16} and FFFF_{16} (Table 1) when Interrupt Acknowledge is true, ($\overline{\text{BA}} \cdot \text{BS}=1$). During initial power-on, the Reset line should be held "Low" until the clock oscillator is fully operational. See Fig. 7.

Because the HD6809 Reset pin has a Schmitt-trigger input with a threshold voltage higher than that of standard peripherals, a simple R/C network may be used to reset the entire system. This higher threshold voltage ensures that all peripherals are out of the reset state before the Processor.

Table 1 Memory Map for Interrupt Vectors

Memory Map For Vector Locations		Interrupt Vector Description
MS	LS	
FFFE	FFFF	$\overline{\text{RES}}$
FFFC	FFFD	$\overline{\text{NMI}}$
FFFA	FFFB	$\overline{\text{SWI}}$
FFF8	FFF9	$\overline{\text{IRQ}}$
FFF6	FFF7	$\overline{\text{FIRQ}}$
FFF4	FFF5	$\overline{\text{SWI2}}$
FFF2	FFF3	$\overline{\text{SWI3}}$
FFF0	FFF1	Reserved

● **$\overline{\text{HALT}}$**

A "Low" level on this input pin will cause the MPU to stop running at the end of the present instruction and remain halted indefinitely without loss of data. When halted, the BA output is driven "High" indicating the buses are high impedance. BS is also "High" which indicates the processor is in the Halt or Bus Grant state. While halted, the MPU will not respond to external real-time requests ($\overline{\text{FIRQ}}$, $\overline{\text{IRQ}}$) although $\overline{\text{DMA/BREQ}}$ will always be accepted, and $\overline{\text{NMI}}$ or $\overline{\text{RES}}$ will be latched for later response. During the Halt state Q and E continue to run normally. If the MPU is not running ($\overline{\text{RES}}$, $\overline{\text{DMA/BREQ}}$), a halted state ($\overline{\text{BA}} \cdot \text{BS}=1$) can be achieved by pulling $\overline{\text{HALT}}$ "Low" while $\overline{\text{RES}}$ is still "Low". If $\overline{\text{DAM/BREQ}}$ and $\overline{\text{HALT}}$ are both pulled "Low", the processor will reach the last cycle of the instruction (by reverse cycle stealing) where the machine will then become halted. See Figs. 8 and 16.

● **Bus Available, Bus Status (BA, BS)**

The BA output is an indication of an internal control signal which makes the MOS buses of the MPU high impedance. This signal does not imply that the bus will be available for more than one cycle. When BA goes "Low", an additional dead cycle will elapse before the MPU acquires the bus.

The BS output signal, when decoded with BA, represents the MPU state (valid with leading edge of Q).

Table 2 MPU State Definition

BA	BS	MPU State
0	0	Normal (Running)
0	1	Interrupt or RESET Acknowledge
1	0	SYNC Acknowledge
1	1	$\overline{\text{HALT}}$ or Bus Grant

Interrupt Acknowledge is indicated during both cycles of a hardware-vector-fetch ($\overline{\text{RES}}$, $\overline{\text{NMI}}$, $\overline{\text{FIRQ}}$, $\overline{\text{IRQ}}$, $\overline{\text{SWI}}$, $\overline{\text{SWI2}}$, $\overline{\text{SWI3}}$). This signal, plus decoding of the lower four address lines, can provide the user with an indication of which interrupt level is being serviced and allow vectoring by device. See Table 1.

Sync Acknowledge is indicated while the MPU is waiting for external synchronization on an interrupt line.

Halt/Bus Grant is true when the HD6809 is in a Halt or Bus Grant condition.

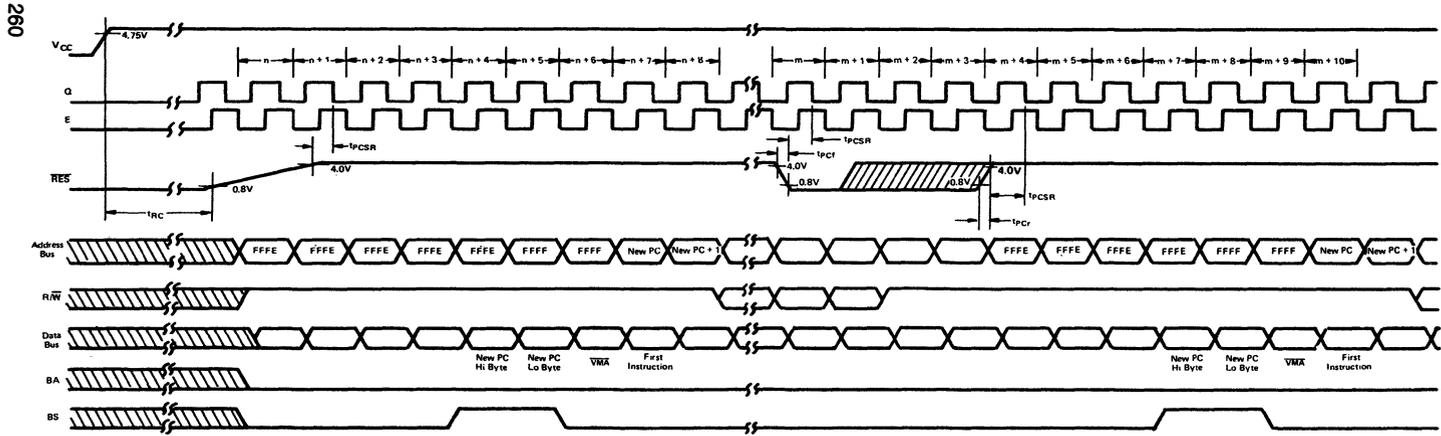


Figure 6 RES Timing

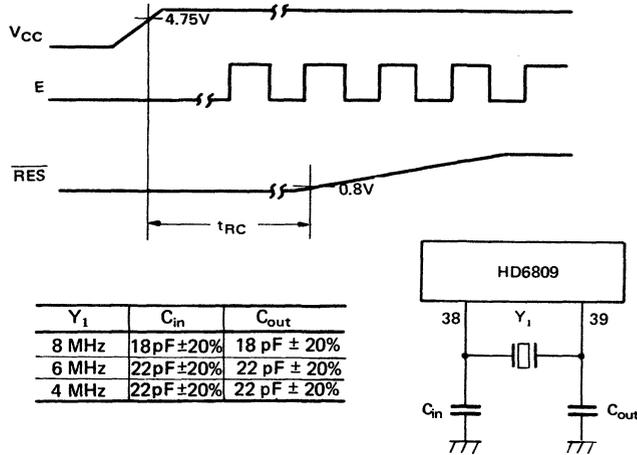


Figure 7 Crystal Connections and Oscillator Start Up

• **Non Maskable Interrupt (NMI)***

A negative edge on this input requests that a non-maskable interrupt sequence be generated. A non-maskable interrupt cannot be inhibited by the program, and also has a higher priority than $\overline{\text{FIRQ}}$, $\overline{\text{IRQ}}$ or software interrupts. During recognition of an NMI, the entire machine state is saved on the

hardware stack. After reset, an $\overline{\text{NMI}}$ will not be recognized until the first program load of the Hardware Stack Pointer (S). The pulse width of $\overline{\text{NMI}}$ "Low" must be at least one E cycle. If the $\overline{\text{NMI}}$ input does not meet the minimum set up with respect to Q, the interrupt will not be recognized until the next cycle. See Fig. 9.

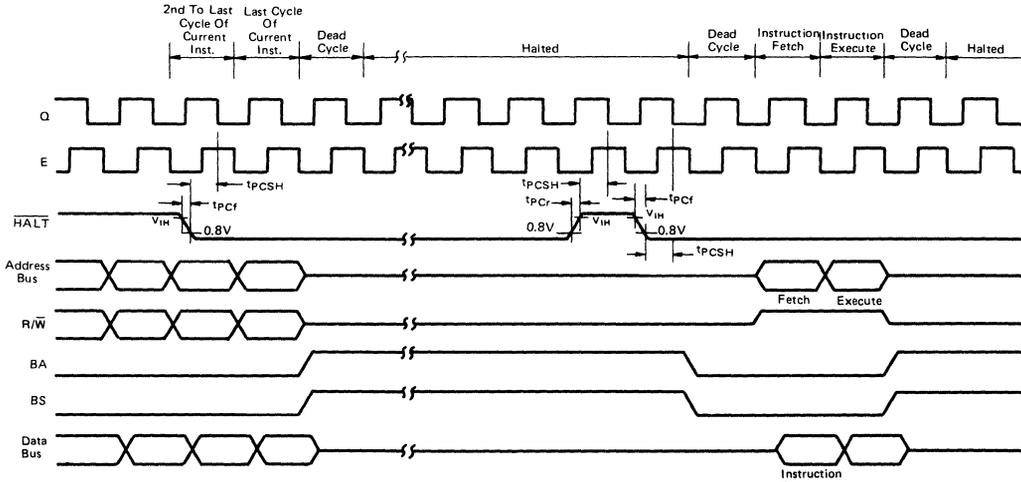


Figure 8 $\overline{\text{HALT}}$ and Single Instruction Execution for System Debug

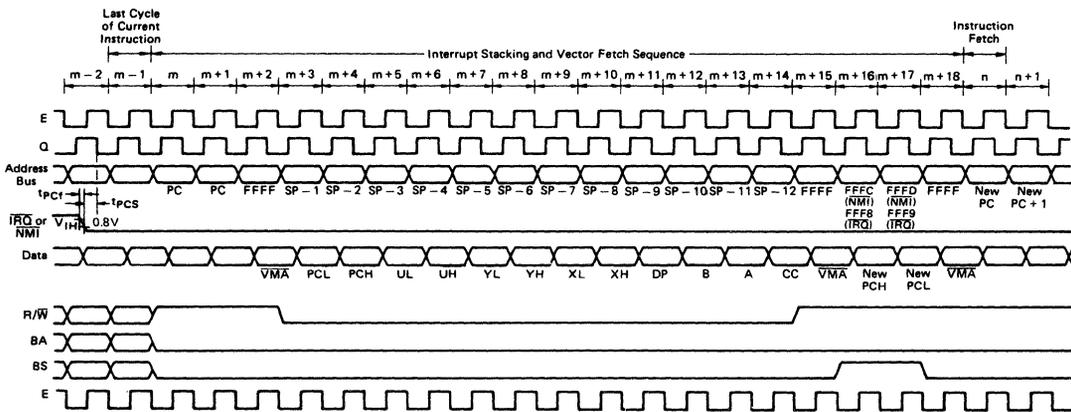


Figure 9 $\overline{\text{IRQ}}$ and $\overline{\text{NMI}}$ Interrupt Timing

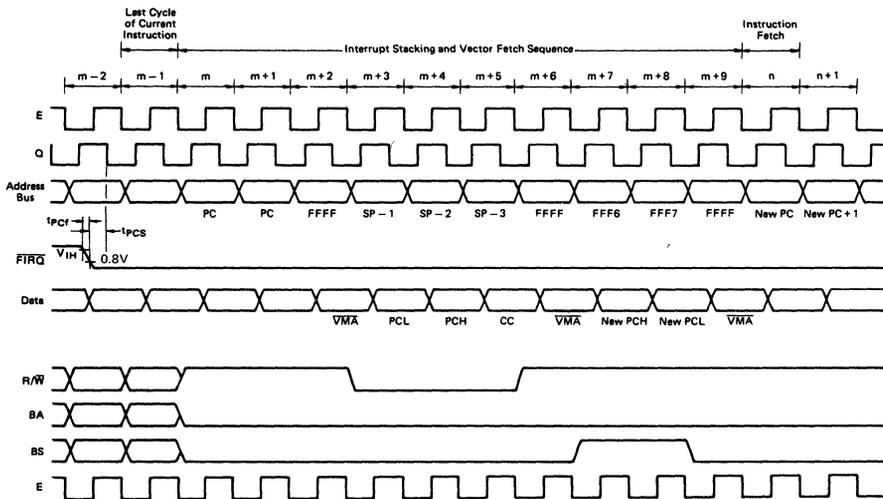


Figure 10 $\overline{\text{FIRQ}}$ Interrupt Timing

● **Fast-Interrupt Request ($\overline{\text{FIRQ}}$)***

A “Low” level on this input pin will initiate a fast interrupt sequence provided its mask bit (F) in the CC is clear. This sequence has priority over the standard Interrupt Request ($\overline{\text{IRQ}}$), and is fast in the sense that it stacks only the contents of the condition code register and the program counter. The interrupt service routine should clear the source of the interrupt before doing an RTI. See Fig. 10.

● **Interrupt Request ($\overline{\text{IRQ}}$)***

A “Low” level input on this pin will initiate an interrupt sequence provided the mask bit (I) in the CC is clear. Since $\overline{\text{IRQ}}$ stacks the entire machine state it provides a slower response to interrupts than $\overline{\text{FIRQ}}$. $\overline{\text{IRQ}}$ also has a lower priority than $\overline{\text{FIRQ}}$. Again, the interrupt service routine should clear the source of the interrupt before doing an RTI. See Fig. 9.

* **NMI, $\overline{\text{FIRQ}}$, and $\overline{\text{IRQ}}$ requests are sampled on the falling edge of Q. One cycle is required for synchronization before these interrupts are recognized. The pending interrupt(s) will not be serviced until completion of the current instruction unless a SYNC or CWAI condition is present. If $\overline{\text{IRQ}}$ and $\overline{\text{FIRQ}}$ do not remain “Low” until completion of the current instruction they may not be recognized. However, NMI is latched and need only remain “Low” for one cycle.**

● **XTAL, EXTAL**

These inputs are used to connect the on-chip oscillator to an external parallel-resonant crystal. Alternately, the pin EXTAL may be used as a TTL level input for external timing by grounding XTAL. The crystal or external frequency is four times the bus frequency. See Fig. 7. Proper RF layout techniques should be observed in the layout of printed circuit boards.

< **NOTE FOR BOARD DESIGN OF THE OSCILLATION CIRCUIT** >

In designing the board, the following notes should be taken when the crystal oscillator is used.

- 1) Crystal oscillator and load capacity C_{in} , C_{out} must be placed

near the LSI as much as possible.

{ Normal oscillation may be disturbed when external noise is induced to pin 38 and 39. }

- 2) Pin 38 and 39 signal line should be wired apart from other signal line as much as possible. Don't wire them in parallel.

{ Normal oscillation may be disturbed when E or Q signal is feedbacked to pin 38 and 39. }

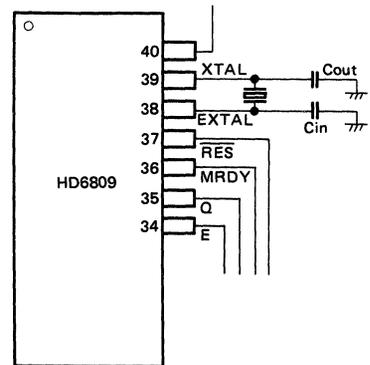


Figure 11 Board Design of the Oscillation Circuit.

< **THE FOLLOWING DESIGN MUST BE AVOIDED** >

A signal line or a power source line must not cross or go near the oscillation circuit line as shown in Fig. 12 to prevent the induction from these lines and perform the correct oscillation. The resistance among XTAL, EXTAL and other pins should be over 10M Ω .

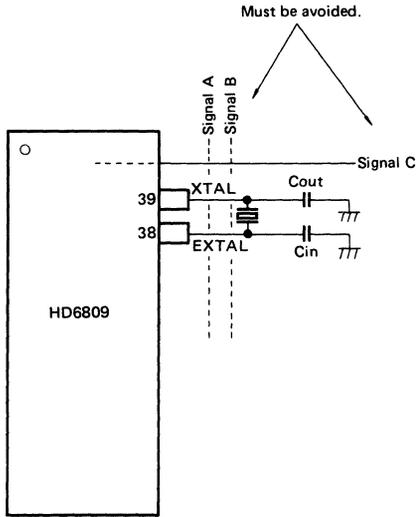


Figure 12 Example of Normal Oscillation may be Disturbed.

• E, Q

E is similar to the HD6800 bus timing signal ϕ_2 ; Q is a quadrature clock signal which leads E. Q has no parallel on the HD6800. Addresses from the MPU will be valid with the leading edge of Q. Data is latched on the falling edge of E. Timing for E and Q is shown in Fig. 13.

• MRDY

This input control signal allows stretching of E and Q to extend data-access time. E and Q operate normally while MRDY is "High". When MRDY is "Low", E and Q may be stretched in integral multiples of quarter (1/4) bus cycles, thus allowing interface to slow memories, as shown in Fig. 14. A maximum

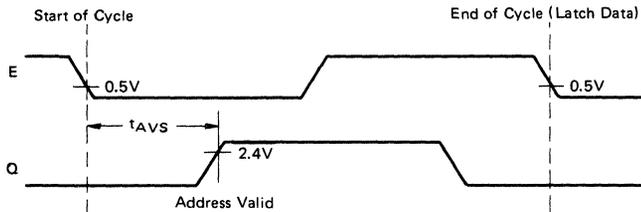


Figure 13 E/Q Relationship

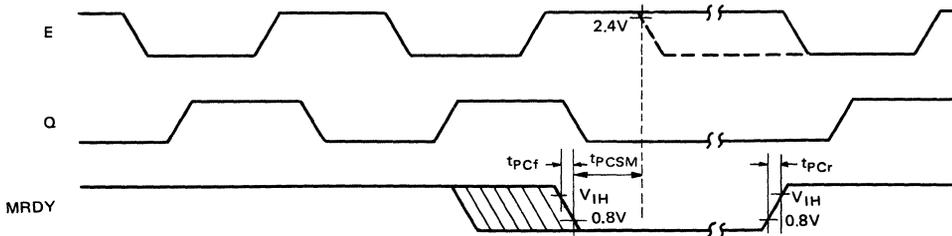


Figure 14 MRDY Timing

stretch is 10 microseconds. During nonvalid memory access (VMA cycles) MRDY has no effect on stretching E and Q; this inhibits slowing the processor during "don't care" bus accesses. MRDY may also be used to stretch clocks (for slow memory) when bus control has been transferred to an external device (through the use of HALT and DMA/BREQ).

Also MRDY has effect on stretching E and Q during Dead Cycle.

● **DMA/BREQ**

The DMA/BREQ input provides a method of suspending execution and acquiring the MPU bus for another use, as shown in Fig. 15. Typical uses include DMA and dynamic memory refresh.

Transition of DMA/BREQ should occur during Q. A "Low" level on this pin will stop instruction execution at the end of the current cycle. The MPU will acknowledge DMA/BREQ by setting BA and BS to "High" level. The requesting device will now have up to 15 bus cycles before the MPU retrieves the bus for self-refresh. Self-refresh requires one bus cycle with a lead-

ing and trailing dead cycle. See Fig. 16.

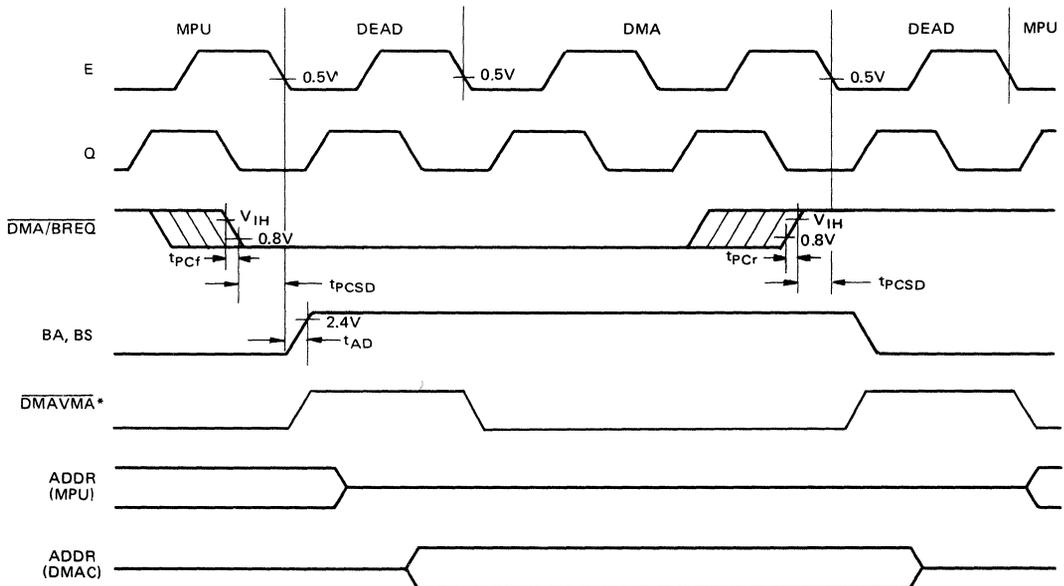
Typically, the DMA controller will request to use the bus by asserting DMA/BREQ pin "Low" on the leading edge of E. When the MPU replies by setting BA and BS to a one, that cycle will be a dead cycle used to transfer bus mastership to the DMA controller.

False memory accesses may be prevented during and dead cycles by developing a system DMAVMA signal which is "Low" in any cycle when BA has changed.

When BA goes "Low" (either as a result of DMA/BREQ = "High" or MPU self-refresh), the DMA device should be taken off the bus. Another dead cycle will elapse before the MPU accesses memory, to allow transfer of bus mastership without contention.

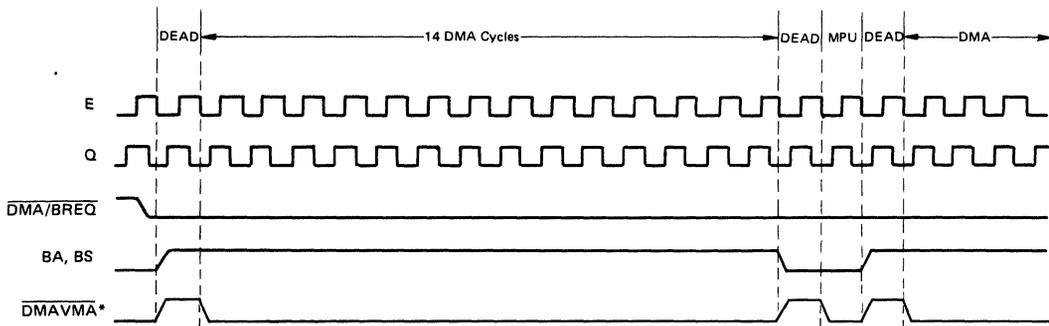
■ **MPU OPERATION**

During normal operation, the MPU fetches an instruction from memory and then executes the requested function. This



*DMAVMA is a signal which is developed externally, but is a system requirement for DMA.

Figure 15 Typical DMA Timing (<14 Cycles)



*DMAVMA is a signal which is developed externally, but is a system requirement for DMA.

Figure 16 Auto-Refresh DMA Timing (Reverse Cycle Stealing)

sequence begins at RES and is repeated indefinitely unless altered by a special instruction or hardware occurrence. Software instructions that alter normal MPU operation are: SWI, SWI2, SWI3, CWAI, RTI and SYNC. An interrupt, HALT or DMA/BREQ can also alter the normal execution of instructions. Fig. 17 illustrates the flow chart for the HD6809.

■ ADDRESSING MODES

The basic instructions of any computer are greatly enhanced by the presence of powerful addressing modes. The HD6809 has the most complete set of addressing modes available on any microcomputer today. For example, the HD6809 has 59 basic instructions; however, it recognizes 1464 different variations of instructions and addressing modes. The addressing modes support modern programming techniques. The following addressing modes are available on the HD6809:

- (1) Implied (Includes Accumulator)
- (2) Immediate
- (3) Extended
- (4) Extended Indirect
- (5) Direct
- (6) Register
- (7) Indexed
 - Zero-Offset
 - Constant Offset
 - Accumulator Offset
 - Auto Increment/Decrement
- (8) Indexed Indirect
- (9) Relative
- (10) Program Counter Relative

● Implied (Includes Accumulator)

In this addressing mode, the opcode of the instruction contains all the address information necessary. Examples of Implied Addressing are: ABX, DAA, SWI, ASRA, and CLRBC.

● Immediate Addressing

In Immediate Addressing, the effective address of the data is the location immediately following the opcode (i.e., the data to be used in the instruction immediately follows the opcode of the instruction). The HD6809 uses both 8 and 16-bit immediate values depending on the size of argument specified by the opcode. Examples of instructions with Immediate Addressing are:

```
LDA #$20
LDX #$F000
LDY #CAT
```

(NOTE) # signifies Immediate addressing, \$ signifies hexadecimal value.

● Extended Addressing

In Extended Addressing, the contents of the two bytes immediately following the opcode fully specify the 16-bit effective address used by the instruction. Note that the address generated by an extended instruction defines an absolute address and is not position independent. Examples of Extended Addressing include:

```
LDA CAT
STX MOUSE
LDD $2000
```

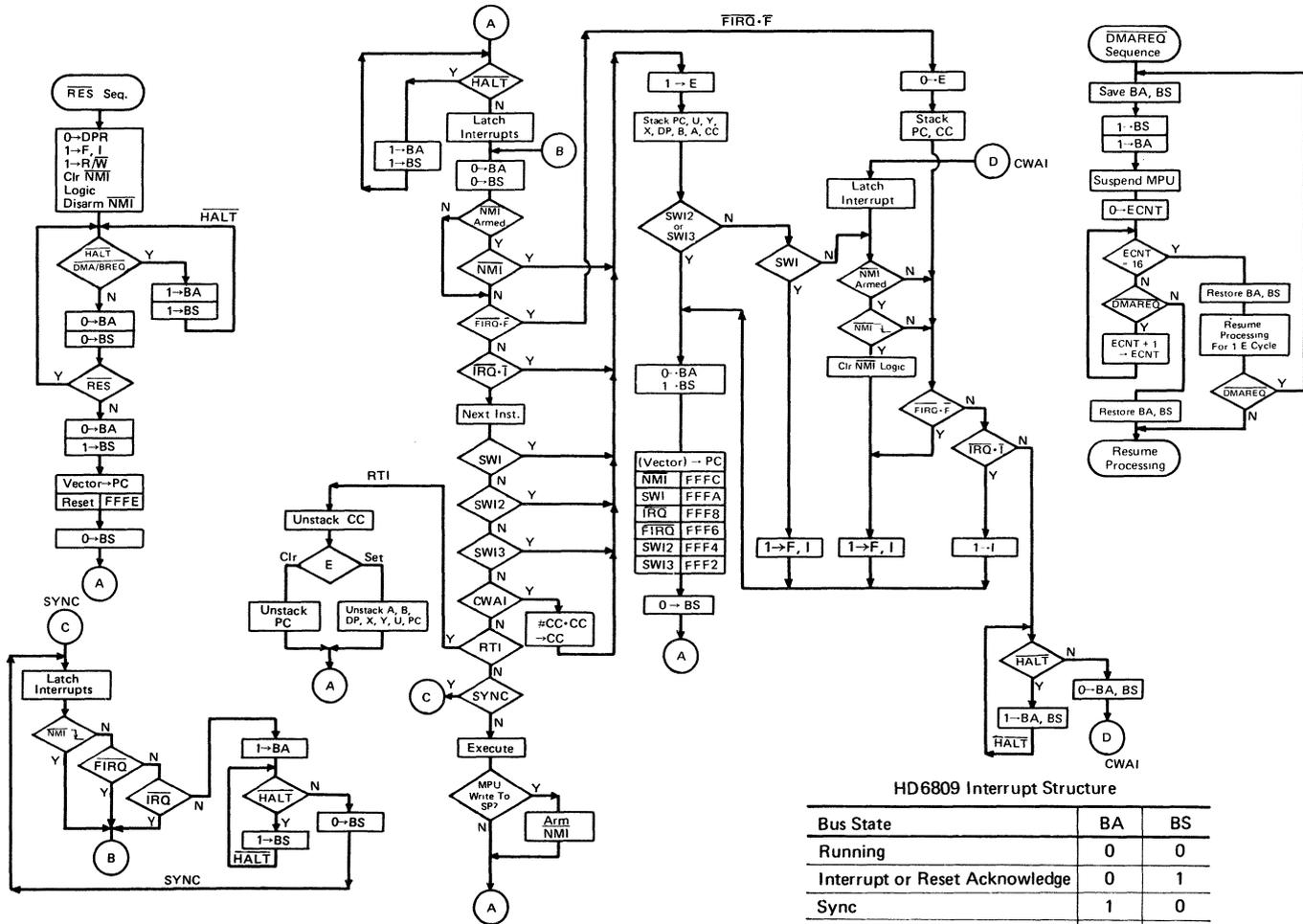
● Extended Indirect

As a special case of indexed addressing (discussed below), "1" level of indirection may be added to Extended Addressing. In Extended Indirect, the two bytes following the postbyte of an Indexed instruction contain the address of the data.

```
LDA [CAT]
LDX [$FFFE]
STU [DOG]
```

● Direct Addressing

Direct addressing is similar to extended addressing except that only one byte of address follows the opcode. This byte specifies the lower 8-bit of the address to be used. The upper 8-bit of the address are supplied by the direct page register. Since only one byte of address is required in direct addressing, this mode requires less memory and executes faster than extended addressing. Of course, only 256 locations (one page) can be



(NOTE) Asserting \overline{RES} will result in entering the reset sequence from any point in the flow chart.

Figure 17 Flowchart for HD6809 Instruction

HD6809 Interrupt Structure

Bus State	BA	BS
Running	0	0
Interrupt or Reset Acknowledge	0	1
Sync	1	0
Halt/Bus Grant	1	1

accessed without redefining the contents of the DP register. Since the DP register is set to \$00 on Reset, direct addressing on the HD6809 is compatible with direct addressing on the HD6800. Indirection is not allowed in direct addressing. Some examples of direct addressing are:

```
LDA    $30
SETDP  $10 (Assembler directive)
LDB    $1030
LDD    <CAT
```

(NOTE) < is an assembler directive which forces direct addressing.

• **Register Addressing**

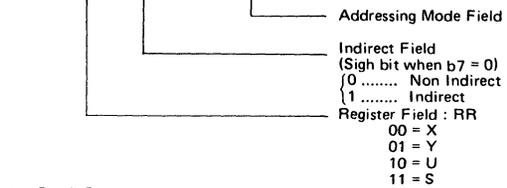
Some opcodes are followed by a byte that defines a register or set of registers to be used by the instruction. This is called a postbyte. Some examples of register addressing are:

```
TFR    X, Y    Transfers X into Y
EXG    A, B    Exchanges A with B
PSHS   A, B, X, Y  Push Y, X, B and A onto S
PULU   X, Y, D  Pull D, X, and Y from U
```

• **Indexed Addressing**

In all indexed addressing, one of the pointer registers (X, Y, U, S, and sometimes PC) is used in a calculation of the effective address of the operand to be used by the instruction. Five basic types of indexing are available and are discussed below. The postbyte of an indexed instruction specifies the basic type and variation of the addressing mode as well as the pointer register to be used. Fig. 18 lists the legal formats for the postbyte. Table 3 gives the assembler form and the number of cycles and bytes

Post-Byte Register Bit								Indexed Addressing Mode
7	6	5	4	3	2	1	0	
0	R	R	x	x	x	x	x	EA = ,R + 5 Bit Offset
1	R	R	0	0	0	0	0	,R +
1	R	R	0/1	0	0	0	1	,R ++
1	R	R	0	0	0	1	0	, -R
1	R	R	0/1	0	0	1	1	, -- R
1	R	R	0/1	0	1	0	0	EA = ,R + 0 Offset
1	R	R	0/1	0	1	0	1	EA = ,R + ACCB Offset
1	R	R	0/1	0	1	1	0	EA = ,R + ACCA Offset
1	R	R	0/1	1	0	0	0	EA = ,R + 8 Bit Offset
1	R	R	0/1	1	0	0	1	EA = ,R + 16 Bit Offset
1	R	R	0/1	1	0	1	1	EA = ,R + D Offset
1	x	x	0/1	1	1	0	0	EA = ,PC + 8 Bit Offset
1	x	x	0/1	1	1	0	1	EA = ,PC + 16 Bit Offset
1	R	R	1	1	1	1	1	EA = [,Address]



x = Don't Care

Figure 18 Index Addressing Postbyte Register Bit Assignments

Table 3 Indexed Addressing Mode

Type	Forms	Non Indirect			Indirect		
		Assembler Form	Postbyte OP Code	+ ~ #	Assembler Form	Postbyte OP Code	+ ~ #
Constant Offset From R (2's Complement Offsets)	No Offset	,R	1RR00100	0 0	[,R]	1RR10100	3 0
	5 Bit Offset	n, R	0RRnnnnn	1 0	defaults to 8-bit		
	8 Bit Offset	n, R	1RR01000	1 1	[n, R]	1RR11000	4 1
	16 Bit Offset	n, R	1RR01001	4 2	[n, R]	1RR11001	7 2
Accumulator Offset From R (2's Complement Offsets)	A Register Offset	A, R	1RR00110	1 0	[A, R]	1RR10110	4 0
	B Register Offset	B, R	1RR00101	1 0	[B, R]	1RR10101	4 0
	D Register Offset	D, R	1RR01011	4 0	[D, R]	1RR11011	7 0
Auto Increment/Decrement R	Increment By 1	,R +	1RR00000	2 0	not allowed		
	Increment By 2	,R ++	1RR00001	3 0	[,R ++]	1RR10001	6 0
	Decrement By 1	, -R	1RR00010	2 0	not allowed		
	Decrement By 2	, -- R	1RR00011	3 0	[, -- R]	1RR10011	6 0
Constant Offset From PC (2's Complement Offsets)	8 Bit Offset	n, PCR	1xx01100	1 1	[n, PCR]	1xx11100	4 1
	16 Bit Offset	n, PCR	1xx01101	5 2	[n, PCR]	1xx11101	8 2
Extended Indirect	16 Bit Address	-	-	-	[n]	10011111	5 2

R = X, Y, U or S RR:
 x = Don't Care 00 = X
 01 = Y
 10 = U
 11 = S

+ and # indicate the number of additional cycles and bytes for the particular variation.

added to the basic values for indexed addressing for each variation.

Zero-Offset Indexed

In this mode, the selected pointer register contains the effective address of the data to be used by the instruction. This is the fastest indexing mode.

Examples are:
 LDD 0,X
 LDA S

Constant Offset Indexed

In this mode, a two's-complement offset and the contents of one of the pointer registers are added to form the effective address of the operand. The pointer register's initial content is unchanged by the addition.

Three sizes of offsets are available:
 5-bit (-16 to +15)
 8-bit (-128 to +127)
 16-bit (-32768 to +32767)

The two's complement 5-bit offset is included in the postbyte and, therefore, is most efficient in use of bytes and cycles. The two's complement 8-bit offset is contained in a single byte following the postbyte. The two's complement 16-bit offset is in the two bytes following the postbyte. In most cases the programmer need not be concerned with the size of this offset since the assembler will select the optimal size automatically.

Examples of constant-offset indexing are:
 LDA 23,X
 LDX -2,S
 LDY 300,X
 LDU CAT,Y

Accumulator-Offset Indexed

This mode is similar to constant offset indexed except that the two's-complement value in one of the accumulators (A, B or D) and the contents of one of the pointer registers are added to form the effective address of the operand. The contents of both the accumulator and the pointer register are unchanged by the addition. The postbyte specifies which accumulator to use as an offset and no additional bytes are required. The advantage of an accumulator offset is that the value of the offset can be calculated by a program at run-time.

Some examples are:
 LDA B,Y
 LDX D,Y
 LEAX B,X

Auto Increment/Decrement Indexed

In the auto increment addressing mode, the pointer register contains the address of the operand. Then, after the pointer register is used it is incremented by one or two. This addressing mode is useful in stepping through tables, moving data, or for the creation of software stacks. In auto decrement, the pointer register is decremented prior to use as the address of the data. The use of auto decrement is similar to that of auto increment; but the tables, etc., are scanned from the "High" to "Low" addresses. The size of the increment/decrement can be either one or two to allow for tables of either 8 or 16-bit data to be accessed and is selectable by the programmer. The pre-decrement, post-increment nature of these modes allow them to be used to create additional software stacks that behave identically to the U and S stacks.

Some examples of the auto increment/decrement addressing modes are:

LDA ,X+
 STD ,Y+ +
 LDB , -Y
 LDX , - -S

Care should be taken in performing operations on 16-bit pointer registers (X, Y, U, S) where the same register is used to calculate the effective address.

Consider the following instruction:

STX 0, X ++ (X initialized to 0)

The desired result is to store a 0 in locations \$0000 and \$0001 then increment X to point to \$0002. In reality, the following occurs:

0 → temp calculate the EA; temp is a holding register
 X + 2 → X perform autoincrement
 X → (temp) do store operation

● **Indexed Indirect**

All of the indexing modes with the exception of auto increment/decrement by one, or a ±4-bit offset may have an additional level of indirection specified. In indirect addressing, the effective address is contained at the location specified by the contents of the Index register plus any offset. In the example below, the A accumulator is loaded indirectly using an effective address calculated from the Index register and an offset.

Before Execution
 A = ×× (don't care)
 X = \$F000
 \$0100 LDA [\$10,X] EA is now \$F010
 \$F010 \$F1 \$F150 is now the
 \$F011 \$50 new EA
 \$F150 SAA
 After Execution
 A = SAA Actual Data Loaded
 X = \$F000

All modes of indexed indirect are included except those which are meaningless (e.g., auto increment/decrement by 1 indirect). Some examples of indexed indirect are:

LDA [,X]
 LDD [10,S]
 LDA [B,Y]
 LDD [,X+ +]

● **Relative Addressing**

The byte(s) following the branch opcode is (are) treated as a signed offset which may be added to the program counter. If the branch condition is true then the calculated address (PC + signed offset) is loaded into the program counter. Program execution continues at the new location as indicated by the PC; short (1 byte offset) and long (2 bytes offset) relative addressing modes are available. All of memory can be reached in long relative addressing as an effective address is interpreted modulo 2¹⁶. Some examples of relative addressing are:

	BEQ	CAT	(short)
	BGT	DOG	(short)
CAT	LBEQ	RAT	(long)
DOG	LBGT	RABBIT	(long)

•
•
•
RAT NOP
RABBIT NOP

● Program Counter Relative

The PC can be used as the pointer register with 8 or 16-bit signed offsets. As in relative addressing, the offset is added to the current PC to create the effective address. The effective address is then used as the address of the operand or data. Program Counter Relative Addressing is used for writing position independent programs. Tables related to a particular routine will maintain the same relationship after the routine is moved, if referenced relative to the Program Counter. Examples are:

```
LDA CAT, PCR
LEAX TABLE, PCR
```

Since program counter relative is a type of indexing, an additional level of indirection is available.

```
LDA [CAT, PCR]
LDU [DOG, PCR]
```

■ HD6809 INSTRUCTION SET

The instruction set of the HD6809 is similar to that of the HD6800 and is upward compatible at the source code level. The number of opcodes has been reduced from 72 to 59, but because of the expanded architecture and additional addressing modes, the number of available opcodes (with different addressing modes) has risen from 197 to 1464.

Some of the new instructions and addressing modes are described in detail below:

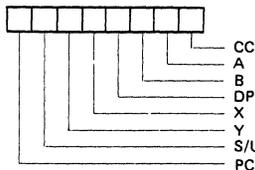
● PSHU/PSHS

The push instructions have the capability of pushing onto either the hardware stack (S) or user stack (U) any single register, or set of registers with a single instruction.

● PULU/PULS

The pull instructions have the same capability of the push instruction, in reverse order. The byte immediately following the push or pull opcode determines which register or registers are to be pushed or pulled. The actual PUSH/PULL sequence is fixed; each bit defines a unique register to push or pull, as shown in below.

PUSH/PULL POST BYTE



← Pull Order Push Order →

PC U Y X DP B A CC
 FFFF... ← increasing memory address0000
 PC S Y X DP B A CC

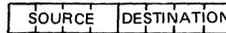
● TFR/EXG

Within the HD6809, any register may be transferred to or exchanged with another of like-size; i.e., 8-bit to 8-bit or 16-bit to 16-bit. Bits 4-7 of postbyte define the source register, while bits 0-3 represent the destination register. Three are denoted as follows:

0000 - D	0101 - PC
0001 - X	1000 - A
0010 - Y	1001 - B
0011 - U	1010 - CC
0100 - S	1011 - DP

(NOTE) All other combinations are undefined and INVALID.

TRANSFER/EXCHANGE POST BYTE



● LEAX/LEAY/LEAU/LEAS

The LEA (Load Effective Address) works by calculating the effective address used in an indexed instruction and stores that address value, rather than the data at that address, in a pointer register. This makes all the features of the internal addressing hardware available to the programmer. Some of the implications of this instruction are illustrated in Table 4.

The LEA instruction also allows the user to access data in a position independent manner. For example:

```
LEAX MSG1, PCR
LBSR PDATA (Print message routine)
```

MSG1 FCC 'MESSAGE'

This sample program prints: 'MESSAGE'. By writing MSG1, PCR, the assembler computes the distance between the present address and MSG1. This result is placed as a constant into the LEAX instruction which will be indexed from the PC value at the time of execution. No matter where the code is located, when it is executed, the computed offset from the PC will put the absolute address of MSG1 into the X pointer register. This code is totally position independent.

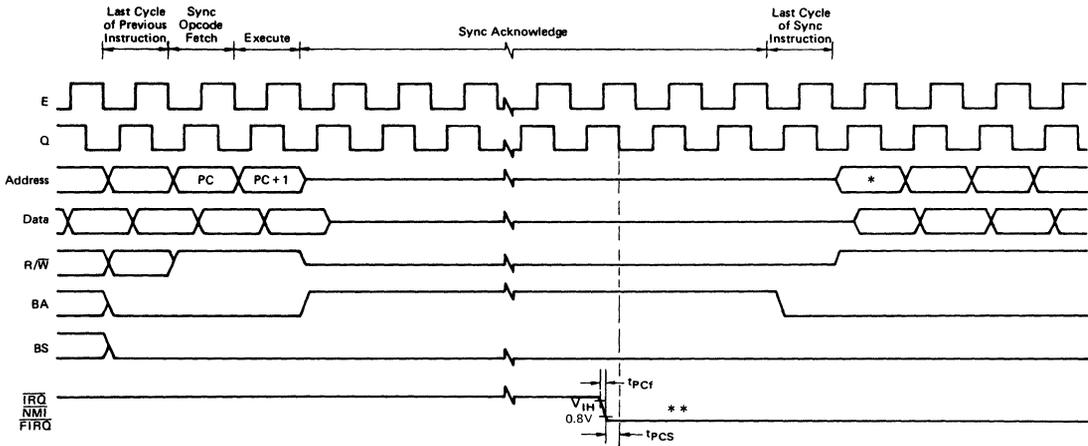
The LEA instructions are very powerful and use an internal holding register (temp). Care must be exercised when using the LEA instructions with the autoincrement and autodecrement addressing modes due to the sequence of internal operations. The LEA internal sequence is outlined as follows:

LEAa, b+ (any of the 16-bit pointer registers X, Y, U or S may be substituted for a and b.)

1. b → temp (calculate the EA)
2. b + 1 → b (modify b, postincrement)
3. temp → a (load a)

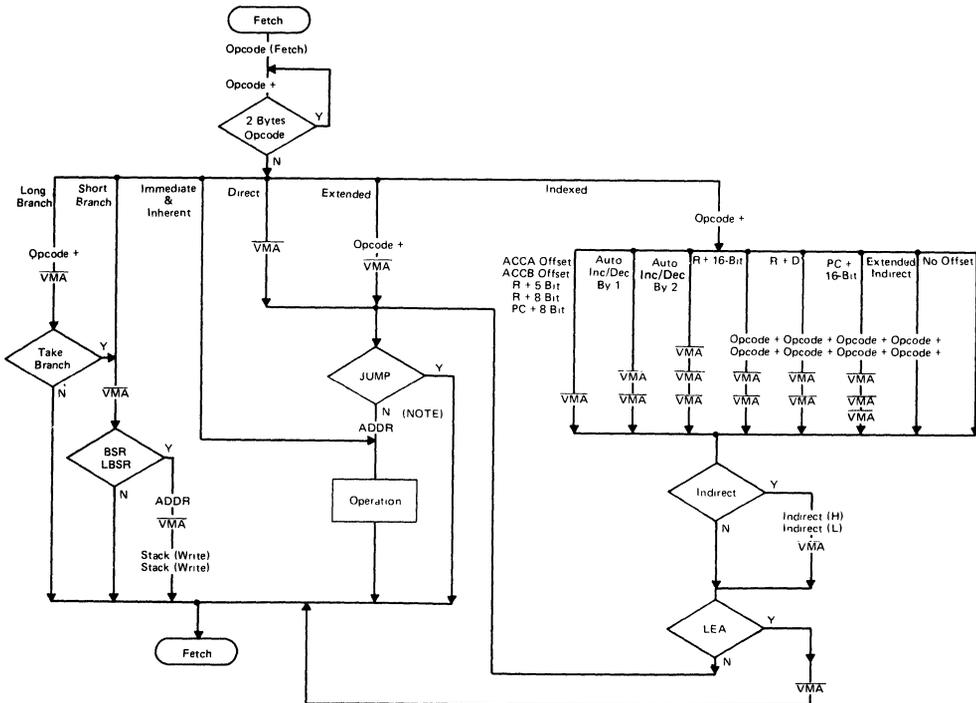
- LEAa, - b
1. b - 1 → temp (calculate EA with predecrement)
 2. b - 1 → b (modify b, predecrement)
 3. temp → a (load a)

Autoincrement-by-two and autodecrement-by-two instructions work similarly. Note that LEAX, X+ does not change X, however LEAX, -X does decrement X. LEAX 1, X should be used to increment X by one.



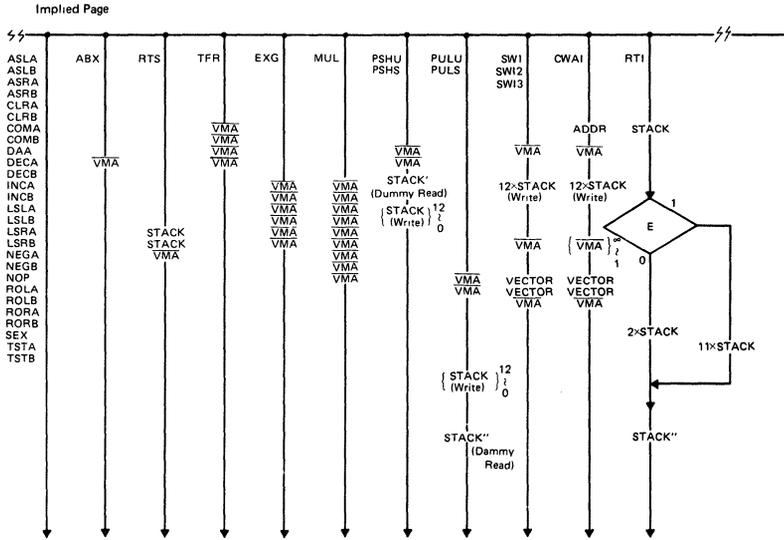
- (NOTES) * If the associated mask bit is set when the interrupt is requested, this cycle will be an instruction fetch from address location PC + 1. However, if the interrupt is accepted (NMI or an unmasked FIRQ or IRQ) interrupt processing continues with this cycle as (m) on Figure 9 and 10 (Interrupt Timing).
 ** If mask bits are clear, \overline{IRQ} and \overline{FIRQ} must be held "Low" for three cycles to guarantee that interrupt will be taken, although only one cycle is necessary to bring the processor out of SYNC.

Figure 19 Sync Timing



(NOTE) Write operation during store instruction.

Figure 20 Address Bus Cycle-by-Cycle Performance



(NOTE) STACK': Address stored in stack pointer before execution.
 STACK'': Address set to stack pointer as the result of the execution.

Figure 20 Address Bus Cycle-by-Cycle Performance (Continued)

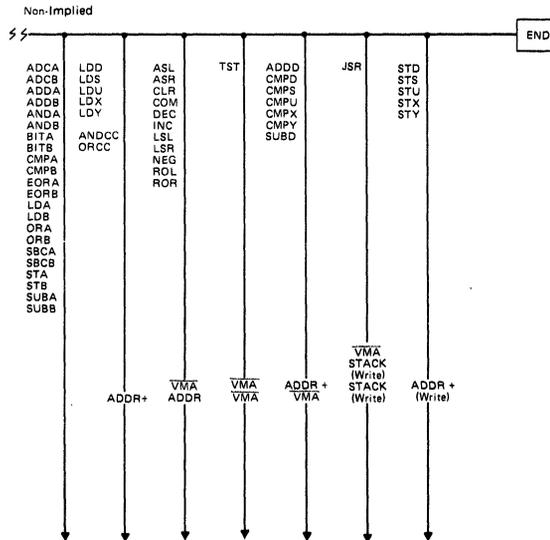


Figure 20 Address Bus Cycle-by-Cycle Performance (Continued)

Table 5 8-Bit Accumulator and Memory Instructions

Mnemonic(s)	Operation
ADCA, ADCB	Add memory to accumulator with carry
ADDA, ADDB	Add memory to accumulator
ANDA, ANDB	And memory with accumulator
ASL, ASLA, ASLB	Arithmetic shift of accumulator or memory left
ASR, ASRA, ASRB	Arithmetic shift of accumulator or memory right
BITA, BITB	Bit test memory with accumulator
CLR, CLRA, CLRB	Clear accumulator or memory location
CMPA, CMPB	Compare memory from accumulator
COM, COMA, COMB	Complement accumulator or memory location
DAA	Decimal adjust A accumulator
DEC, DECA, DECB	Decrement accumulator or memory location
EORA, EORB	Exclusive or memory with accumulator
EXG R1, R2	Exchange R1 with R2 (R1, R2 = A, B, CC, DP)
INC, INCA, INCB	Increment accumulator or memory location
LDA, LDB	Load accumulator from memory
LSL, LSLA, LSLB	Logical shift left accumulator or memory location
LSR, LSRA, LSRB	Logical shift right accumulator or memory location
MUL	Unsigned multiply ($A \times B \rightarrow D$)
NEG, NEGA, NEGB	Negate accumulator or memory
ORA, ORB	Or memory with accumulator
ROL, ROLA, ROLB	Rotate accumulator or memory left
ROR, RORA, RORB	Rotate accumulator or memory right
SBCA, SBCB	Subtract memory from accumulator with borrow
STA, STB	Store accumulator to memory
SUBA, SUBB	Subtract memory from accumulator
TST, TSTA, TSTB	Test accumulator or memory location
TFR R1, R2	Transfer R1 to R2 (R1, R2 = A, B, CC, DP)

(NOTE) A, B, CC or DP may be pushed to (pulled from) either stack with PSHS, PSHU (PULS, PULU) instructions.

Table 6 16-Bit Accumulator and Memory Instructions

Mnemonic(s)	Operation
ADDD	Add memory to D accumulator
CMPD	Compare memory from D accumulator
EXG D, R	Exchange D with X, Y, S, U or PC
LDD	Load D accumulator from memory
SEX	Sign Extend B accumulator into A accumulator
STD	Store D accumulator to memory
SUBD	Subtract memory from D accumulator
TFR D, R	Transfer D to X, Y, S, U or PC
TFR R, D	Transfer X, Y, S, U or PC to D

(NOTE) D may be pushed (pulled) to either stack with PSHS, PSHU (PULS, PULU) instructions.

Table 7 Index Register/Stack Pointer Instructions

Mnemonic(s)	Operation
CMPS, CMPU	Compare memory from stack pointer
CMPX, CMPY	Compare memory from index register
EXG R1, R2	Exchange D, X, Y, S, U or PC with D, X, Y, S, U or PC
LEAS, LEAU	Load effective address into stack pointer
LEAX, LEAY	Load effective address into index register
LDS, LDU	Load stack pointer from memory
LDX, LDY	Load index register from memory
PSHS	Push A, B, CC, DP, D, X, Y, U, or PC onto hardware stack
PSHU	Push A, B, CC, DP, D, X, Y, S, or PC onto user stack
PULS	Pull A, B, CC, DP, D, X, Y, U or PC from hardware stack
PULU	Pull A, B, CC, DP, D, X, Y, S or PC from user stack
STS, STU	Store stack pointer to memory
STX, STY	Store index register to memory
TFR R1, R2	Transfer D, X, Y, S, U or PC to D, X, Y, S, U or PC
ABX	Add B accumulator to X (unsigned)

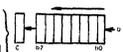
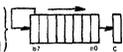
Table 8 Branch Instructions

Mnemonic(s)	Operation
SIMPLE BRANCHES	
BEQ, LBEQ	Branch if equal
BNE, LBNE	Branch if not equal
BMI, LBMI	Branch if minus
BPL, LBPL	Branch if plus
BCS, LBCCS	Branch if carry set
BCC, LBCC	Branch if carry clear
BVS, LBVS	Branch if overflow set
BVC, LBVC	Branch if overflow clear
SIGNED BRANCHES	
BGT, LBGT	Branch if greater (signed)
BGE, LBGE	Branch if greater than or equal (signed)
BEQ, LBEQ	Branch if equal
BLE, LBLE	Branch if less than or equal (signed)
BLT, LBLT	Branch if less than (signed)
UNSIGNED BRANCHES	
BHI, LBHI	Branch if higher (unsigned)
BHS, LBHS	Branch if higher or same (unsigned)
BEQ, LBEQ	Branch if equal
BLS, LBLS	Branch if lower or same (unsigned)
BLO, LBLO	Branch if lower (unsigned)
OTHER BRANCHES	
BSR, LBSR	Branch to subroutine
BRA, LBRA	Branch always
BRN, LBRN	Branch never

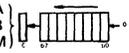
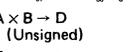
Table 9 Miscellaneous Instructions

Mnemonic(s)	Operation
ANDCC	AND condition code register
CWAI	AND condition code register, then wait for interrupt
NOP	No operation
ORCC	OR condition code register
JMP	Jump
JSR	Jump to subroutine
RTI	Return from interrupt
RTS	Return from subroutine
SWI, SWI2, SWI3	Software interrupt (absolute indirect)
SYNC	Synchronize with interrupt line

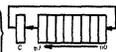
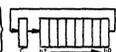
Table 10 HD6809 Instruction Set Table

INSTRUCTION/ FORMS	HD6809 ADDRESSING MODES															DESCRIPTION	5 3 2 1 0							
	IMPLIED			DIRECT			EXTENDED			IMMEDIATE			INDEXED [Ⓞ]				RELATIVE			H	N	Z	V	C
	OP	~	#	OP	~	#	OP	~	#	OP	~	#	OP	~	#		OP	~ ⁽³⁾	#					
ABX	3A	3	1																B + X → X (UNSIGNED)	•	•	•	•	•
ADC	ADCA ADCB			99	4	2	B9	5	3	89	2	2	A9	4+	2+				A + M + C → A B + M + C → B	↑	↑	↑	↑	↑
ADD	ADDA ADDB ADDD			9B	4	2	BB	5	3	8B	2	2	AB	4+	2+				A + M → A B + M → B D + M: M + 1 → D	↑	↑	↑	↑	↑
AND	ANDA ANDB ANDCC			94	4	2	B4	5	3	84	2	2	A4	4+	2+				A ∧ M → A B ∧ M → B CC ∧ IMM → CC	↑	↑	↑	↑	0
ASL	ASLA ASLB ASL	48 58	2 2	1 1															⑧	↑	↑	↑	↑	
ASR	ASRA ASRB ASR	47 57	2 2	1 1	08	6	2	78	7	3			68	6+	2+					⑧	↑	↑	↑	↑
BCC	BCC LBCC															24 10 24	3 5(6) 4	2 4	Branch C = 0 Long Branch C = 0	•	•	•	•	•
BCS	BCS LBCS															25 10 25	3 5(6) 4	2 4	Branch C = 1 Long Branch C = 1	•	•	•	•	•
BEQ	BEQ LBEQ															27 10 27	3 5(6) 4	2 4	Branch Z = 1 Long Branch Z = 1	•	•	•	•	•
BGE	BGE LBGE															2C 10 2C	3 5(6) 4	2 4	Branch N ⊕ V = 0 Long Branch N ⊕ V = 0	•	•	•	•	•
BGT	BGT LBGT															2E 10 2E	3 5(6) 4	2 4	Branch ZV(N ⊕ V) = 0 Long Branch ZV(N ⊕ V) = 0	•	•	•	•	•
BHI	BHI LBHI															22 10 22	3 5(6) 4	2 4	Branch CVZ = 0 Long Branch CVZ = 0	•	•	•	•	•
BHS	BHS LBHS															24 10 24	3 5(6) 4	2 4	Branch C = 0 Long Branch C = 0	•	•	•	•	•
BIT	BITA BITB			95 D5	4 4	2 2	B5 F5	5 5	3 3	85 C5	2 2	2 2	A5 E5	4+ 4+	2+ 2+				Bit Test A (M ∧ A) Bit Test B (M ∧ B)	↑	↑	↑	0	•
BLE	BLE LBLE															2F 10 2F	3 5(6) 4	2 4	Branch ZV(N ⊕ V) = 1 Long Branch ZV(N ⊕ V) = 1	•	•	•	•	•
BLO	BLO LBLO															25 10 25	3 5(6) 4	2 4	Branch C = 1 Long Branch C = 1	•	•	•	•	•
BLS	BLS LBLS															23 10 23	3 5(6) 4	2 4	Branch CVZ = 1 Long Branch CVZ = 1	•	•	•	•	•
BLT	BLT LBLT															2D 10 2D	3 5(6) 4	2 4	Branch N ⊕ V = 1 Long Branch N ⊕ V = 1	•	•	•	•	•
BMI	BMI LBMI															2B 10 2B	3 5(6) 4	2 4	Branch N = 1 Long Branch N = 1	•	•	•	•	•
BNE	BNE LBNE															26 10 26	3 5(6) 4	2 4	Branch Z = 0 Long Branch Z = 0	•	•	•	•	•
BPL	BPL LBPL															2A 10 2A	3 5(6) 4	2 4	Branch N = 0 Long Branch N = 0	•	•	•	•	•
BRA	BRA LBRA															20 16	3 5 3	2 3	Branch Always Long Branch/ Always	•	•	•	•	•
BRN	BRN LBRN															21 10 21	3 5 4	2 4	Branch Never Long Branch Never	•	•	•	•	•

(to be continued)

INSTRUCTION/ FORMS		HD6809 ADDRESSING MODES														DESCRIPTION										
		IMPLIED			DIRECT			EXTENDED			IMMEDIATE			INDEXED ⁽¹⁾			RELATIVE		5	3	2	1	0			
		OP	~	#	OP	~	#	OP	~	#	OP	~	#	OP	~		#	OP	~ ⁽³⁾	#	H	N	Z	V	C	
BSR	BSR															8D	7	2	Branch to Subroutine	•	•	•	•	•		
	LBSR															17	9	3	Long Branch to Subroutine	•	•	•	•	•		
BVC	BVC															28	3	2	Branch V = 0	•	•	•	•	•		
	LBVC															10	5(6)	4	Long Branch V = 0	•	•	•	•	•		
BVS	BVS															29	3	2	Branch V = 1	•	•	•	•	•		
	LBVS															10	5(6)	4	Long Branch V = 1	•	•	•	•	•		
CLR	CLRA	4F	2	1															0 → A	•	0	1	0	0		
	CLRB	5F	2	1															0 → B	•	0	1	0	0		
CMP	CLR				0F	6	2	7F	7	3				6F	6+	2+				0 → M	•	0	1	0	0	
	CMPA				91	4	2	B1	5	3	81	2	2	A1	4+	2+				Compare M from A	•	8	1	1	1	1
CMPB	CMPB				D1	4	2	F1	5	3	C1	2	2	E1	4+	2+				Compare M from B	•	8	1	1	1	1
	CMPD				10	7	3	10	8	4	10	5	4	10	7+	3+				Compare M: M + 1 from D	•	•	1	1	1	1
CMPX	CMPS				93	7	3	B3	8	4	83	5	4	A3	7+	3+				Compare M: M + 1 from S	•	•	1	1	1	1
	CMPU				11	7	3	BC	8	4	8C	5	4	AC	7+	3+				Compare M: M + 1 from U	•	•	1	1	1	1
CMPY	CMPX				9C	6	2	BC	7	3	8C	4	3	AC	6+	2+				Compare M: M + 1 from X	•	•	1	1	1	1
	CMPY				10	7	3	10	8	4	10	5	4	10	7+	3+				Compare M: M + 1 from Y	•	•	1	1	1	1
COM	COMA	43	2	1															A → A	•	1	1	0	1		
	COMB	53	2	1															B → B	•	1	1	0	1		
CWA	COM				03	6	2	73	7	3				63	6+	2+				M → M	•	1	1	0	1	
	CWA	3C	20	2															CC ^ IMM → CC (except 1 → E)	(← 7)						
DAA	DAA	19	2	1															Wait for Interrupt	•	1	1	8	1		
	DECA	4A	2	1															Decimal Adjust A	•	1	1	1	1		
DEC	DECB	5A	2	1															A - 1 → A	•	1	1	1	1		
	DEC				0A	6	2	7A	7	3				6A	6+	2+				B - 1 → B	•	1	1	1	1	
EOR	EORA				98	4	2	B8	5	3	88	2	2	A8	4+	2+				M - 1 → M	•	1	1	1	1	
	EORB				D8	4	2	F8	5	3	C8	2	2	E8	4+	2+				A ⊕ M → A	•	1	1	0	•	
EXG	EXG	1E	7	2															B ⊕ M → B	•	1	1	0	•		
	R1, R2																		R1 ↔ R2 ²	(← 16)						
INC	INCA	4C	2	1															A + 1 → A	•	1	1	1	•		
	INCB	5C	2	1															B + 1 → B	•	1	1	1	•		
JMP	INC				0C	6	2	7C	7	3				6C	6+	2+				M + 1 → M	•	1	1	1	•	
	JMP				0E	3	2	7E	4	3				6E	3+	2+				EA ³ → PC	•	•	•	•	•	
JSR	JSR				9D	7	2	BD	8	3				AD	7+	2+				Jump to Subroutine	•	•	•	•	•	
	LDA				96	4	2	B6	5	3	86	2	2	A6	4+	2+				M → A	•	1	1	0	•	
LD	LDB				D6	4	2	F6	5	3	C6	2	2	E6	4+	2+				M → B	•	1	1	0	•	
	LDD				DC	5	2	FC	6	3	CC	3	3	EC	5+	2+				M: M + 1 → D	•	1	1	0	•	
LDS	LDS				10	6	3	10	7	4	10	4	4	10	6+	3+				M: M + 1 → S	•	1	1	0	•	
	LDU				DE	5	2	FE	6	3	CE	3	3	EE	5+	2+				M: M + 1 → U	•	1	1	0	•	
LDX	LDX				9E	5	2	BE	6	3	8E	3	3	AE	5+	2+				M: M + 1 → X	•	1	1	0	•	
	LDY				10	6	3	10	7	4	10	4	4	10	6+	3+				M: M + 1 → Y	•	1	1	0	•	
LEA	LEA				9E	6	3	10	7	4	10	4	4	10	6+	3+				M: M + 1 → Y	•	1	1	0	•	
	LEAU													32	4+	2+				EA ³ → S	•	•	•	•	•	
LSL	LEAX													33	4+	2+				EA ³ → U	•	•	•	•	•	
	LEAY													30	4+	2+				EA ³ → X	•	•	•	•	•	
LSR	LSLA	48	2	1															EA ³ → Y	•	•	•	•	•		
	LSLB	58	2	1															EA ³ → Y	•	•	•	•	•		
LSR	LSL				08	6	2	78	7	3				68	6+	2+				A) 	•	1	1	1	1	
	LSRA	44	2	1										64	6+	2+				B) 	•	1	1	1	1	
MUL	LSRB	54	2	1										64	6+	2+				M) 	•	0	1	1	1	
	LSR				04	6	2	74	7	3				64	6+	2+				M) 	•	0	1	1	1	
NEG	MUL	3D	11	1														A × B → D (Unsigned)	•	•	1	•	9			
	NEGA	40	2	1															A̅ + 1 → A	•	8	1	1	1		
NOP	NEGB	50	2	1															B̅ + 1 → B	•	8	1	1	1		
	NEG				00	6	2	70	7	3				60	6+	2+				M̅ + 1 → M	•	8	1	1	1	
NOP	NOP	12	2	1															No Operation	•	•	•	•	•		

(to be continued)

INSTRUCTION/ FORMS		HD6809 ADDRESSING MODES															DESCRIPTION																			
		IMPLIED			DIRECT			EXTENDED			IMMEDIATE			INDEXED ^①				RELATIVE			5	3	2	1	0											
		OP	~	#	OP	~	#	OP	~	#	OP	~	#	OP	~	#		OP	~	#	OP	~	#	H	N	Z	V	C								
OR	ORA ORB ORCC				9A DA	4 4	2 2	BA FA	5 5	3 3	8A CA 1A	2 2 2	2 2 2	AA EA	4+ 4+	2+ 2+				A V M → A B V M → B CC V IMM → CC	●	↑	↑	↑	0	●	↑	↑	↑	0	(← 7, →)					
PSH	PSHS PSHU	34 36	5+ ^④ 5+ ^④	2 2															Push Registers on S Stack Push Registers on U Stack	●	●	●	●	●	●	●	●	●	●							
PUL	PULS PULU	35 37	5+ ^④ 5+ ^④	2 2															Pull Registers from S Stack Pull Registers from U Stack	(← 10, →)	(← 10, →)															
ROL	ROLA ROLB ROL	49 59	2 2	1 1																A B M	●	↑	↑	↑	↑	●	↑	↑	↑	↑						
ROR	RORA RORB ROR	46 56	2 2	1 1	09	6	2	79	7	3				69	6+	2+					A B M	●	↑	↑	↑	↑	●	↑	↑	↑	↑					
RTI		3B	6/15	1															Return From Interrupt	(← 7, →)																
RTS		39	5	1															Return From Subroutine		●	●	●	●												
SBC	SBCA SBCB				92 D2	4 4	2 2	B2 F2	5 5	3 3	82 C2	2 2	2 2	A2 E2	4+ 4+	2+ 2+				A - M - C → A B - M - C → B	⑧	↑	↑	↑	↑	⑧	↑	↑	↑	↑						
SEX		1D	2	1															Sign Extend B into A	●	↑	↑	●	●												
ST	STA STB STD STS				97 D7 DD	4 4 5	2 2 2	B7 F7 FD	5 5 6	3 3 3					A7 E7 ED	4+ 4+ 5+	2+ 2+ 2+				A → M B → M D → M: M + 1 S → M: M + 1	●	↑	↑	0	●	●	↑	↑	0	●					
	STU STX STY				DF DF 9F 10 9F	5 5 5 6	2 2 2 3	FF FF BF 10 BF	6 6 6 7	3 3 3 4					EF EF AF 10 AF	5+ 5+ 6+ 6+	2+ 2+ 3+ 3+				U → M: M + 1 X → M: M + 1 Y → M: M + 1	●	↑	↑	0	●	●	↑	↑	0	●					
SUB	SUBA SUBB SUBD				90 D0 93	4 4 6	2 2 2	B0 F0 B3	5 5 7	3 3 3	80 C0 83	2 2 4	2 2 3	A0 E0 A3	4+ 4+ 6+	2+ 2+ 2+				A - M → A B - M → B D - M: M + 1 - D	8	↑	↑	↑	↑	8	↑	↑	↑	↑						
SWI	SWI [Ⓢ] SWI2 [Ⓢ] SWI3 [Ⓢ]	3F 10 3F 11 3F	19 20 20	1 2 2															Software Interrupt1 Software Interrupt2 Software Interrupt3	●	●	●	●	●	●	●	●	●	●							
SYNC		13	>2	1															Synchronize to Interrupt	●	●	●	●	●												
TFR	R1, R2	1F	6	2															R1 → R2 ^②	(← 10, →)																
TST	TSTA TSTB TST	4D 5D	2 2	1 1	0D	6	2	7D	7	3				6D	6+	2+				Test A Test B Test M	●	↑	↑	0	●	●	↑	↑	0	●						

(NOTES)

- ① This column gives a base cycle and byte count. To obtain total count, and the values obtained from the INDEXED ADDRESSING MODES table.
- ② R1 and R2 may be any pair of 8 bit or any pair of 16 bit registers.
The 8 bit registers are: A, B, C, DP
The 16 bit registers are: X, Y, U, S, D, PC
- ③ EA is the effective address.
- ④ The PSH and PUL instructions require 5 cycle plus 1 cycle for each byte pushed or pulled.
- ⑤ 5(6) means: 5 cycles if branch not taken, 6 cycles if taken.
- ⑥ SWI sets 1 and F bits. SWI2 and SWI3 do not affect I and F.
- ⑦ Conditions Codes set as a direct result of the instruction.
- ⑧ Value of half-carry flag is undefined.
- ⑨ Special Case - Carry set if b7 is SET.
- ⑩ Condition Codes set as a direct result of the instruction if CC is specified, and not affected otherwise.

LEGEND:

OP	Operation Code (Hexadecimal)	Z	Zero (byte)
~	Number of MPU Cycles	V	Overflow, 2's complement
#	Number of Program Bytes	C	Carry from bit 7
+	Arithmetic Plus	↑	Test and set if true, cleared otherwise
-	Arithmetic Minus	●	Not Affected
x	Multiply	CC	Condition Code Register
M	Complement of M	:	Concatenation
→	Transfer Into	∨	Logical or
H	Half-carry (from bit 3)	^	Logical and
N	Negative (sign bit)	⊕	Logical Exclusive or

Table 11 Hexadecimal Values of Machine Codes

OP	Mnem	Mode	~	#	OP	Mnem	Mode	~	#	OP	Mnem	Mode	~	#
00	NEG	Direct	6	2	30	LEAX	Indexed	4+	2+	60	NEG	Indexed	6+	2+
01	*	↑			31	LEAY	↑	4+	2+	61	*	↑		
02	*				32	LEAS		4+	2+	62	*			
03	COM		6	2	33	LEAU	Indexed	4+	2+	63	COM		6+	2+
04	LSR		6	2	34	PSHS	↑	5+	2	64	LSR		6+	2+
05	*				35	PULS		5+	2	65	*			
06	ROR		6	2	36	PSHU		5+	2	66	ROR		6+	2+
07	ASR		6	2	37	PULU		5+	2	67	ASR		6+	2+
08	ASL, LSL		6	2	38	*	↑			68	ASL, LSL		6+	2+
09	ROL		6	2	39	RTS		5	1	69	ROL		6+	2+
0A	DEC		6	2	3A	ABX		3	1	6A	DEC		6+	2+
0B	*				3B	RTI		6, 15	1	6B	*			
0C	INC		6	2	3C	CWAI	↓	20	2	6C	INC		6+	2+
0D	TST		6	2	3D	MUL		11	1	6D	TST		6+	2+
0E	JMP		3	2	3E	*				6E	JMP		3+	2+
0F	CLR	Direct	6	2	3F	SWI	Implied	19	1	6F	CLR	Indexed	6+	2+
10	} See Next Page	—	—	—	40	NEGA	↑	2	1	70	NEG	↑	7	3
11		—	—	—	41	*					71		*	
12	NOP	Implied	2	1	42	*				72	*			
13	SYNC	Implied	2	1	43	COMA		2	1	73	COM		7	3
14	*				44	LSRA		2	1	74	LSR		7	3
15	*				45	*				75	*			
16	LBRA	Relative	5	3	46	RORA		2	1	76	ROR		7	3
17	LBSR	Relative	9	3	47	ASRA		2	1	77	ASR		7	3
18	*				48	ASLA, LSLA		2	1	78	ASL, LSL		7	3
19	DAA	Implied	2	1	49	ROLA		2	1	79	ROL		7	3
1A	ORCC	Immed	3	2	4A	DECA		2	1	7A	DEC		7	3
1B	*				4B	*				7B	*			
1C	ANDCC	Immed	3	2	4C	INCA		2	1	7C	INC		7	3
1D	SEX	Implied	2	1	4D	TSTA		2	1	7D	TST		7	3
1E	EXG	↑	8	2	4E	*	↓			7E	JMP		4	3
1F	TFR		Implied	6	2	4F		CLRA	Implied	2	1	7F	CLR	Extended
20	BRA	↑	3	2	50	NEGB	↑	2	1	80	SUBA	↑	2	2
21	BRN			3	2	51		*			81		CMPA	
22	BHI		3	2	52	*				82	SBCA		2	2
23	BLS		3	2	53	COMB		2	1	83	SUBD		4	3
24	BHS, BCC		3	2	54	LSRB		2	1	84	ANDA		2	2
25	BLO, BCS		3	2	55	*				85	BITA		2	2
26	BNE		3	2	56	RORB		2	1	86	LDA		2	2
27	BEQ		3	2	57	ASRB		2	1	87	*			
28	BVC		3	2	58	ASLB, LSLB		2	1	88	EORA		2	2
29	BVS		3	2	59	ROLB		2	1	89	ADCA		2	2
2A	BPL		3	2	5A	DECB		2	1	8A	ORA		2	2
2B	BMI		3	2	5B	*				8B	ADDA		2	2
2C	BGE		3	2	5C	INCB		2	1	8C	CMPX	Immed	4	3
2D	BLT		3	2	5D	TSTB		2	1	8D	BSR	Relative	7	2
2E	BGT	↓	3	2	5E	*	↓			8E	LDX	↑	3	3
2F	BLE		Relative	3	2	5F		CLRB	Implied	2	1		8F	*

LEGEND:
 ~ Number of MPU cycles (less possible push pull or indexed-mode cycles)
 # Number of program bytes
 * Denotes unused opcode

(to be continued)

OP	Mnem	Mode	~	#	OP	Mnem	Mode	~	#	OP	Mnem	Mode	~	#
90	SUBA	Direct	4	2	C6	LDB	Immed	2	2	FC	LDD	Extended	6	3
91	CMPA	↑	4	2	C7	*	↑			FD	STD	↑	6	3
92	SBCA	↑	4	2	C8	EORB	↑	2	2	FE	LDU	↓	6	3
93	SUBD	↑	6	2	C9	ADCB	↑	2	2	FF	STU	Extended	6	3
94	ANDA	↑	4	2	CA	ORB	↑	2	2	2 Bytes Opcode				
95	BITA	↑	4	2	CB	ADDB	↑	2	2					
96	LDA	↑	4	2	CC	LDD	↑	3	3	1021	LBRN	Relative	5	4
97	STA	↑	4	2	CD	*	↓			1022	LBHI	↑	5(6)	4
98	EORA	↑	4	2	CE	LDU	Immed	3	3	1023	LBSL	↑	5(6)	4
99	ADCA	↑	4	2	CF	*	↑			1024	LBHS, LBCC	↑	5(6)	4
9A	ORA	↑	4	2			↑			1025	LBSC, LBLO	↑	5(6)	4
9B	ADDA	↑	4	2	D0	SUBB	Direct	4	2	1026	LBNE	↑	5(6)	4
9C	CMPX	↑	6	2	D1	CMPB	↑	4	2	1027	LBEQ	↑	5(6)	4
9D	JSR	↑	7	2	D2	SBCB	↑	4	2	1028	LBVC	↑	5(6)	4
9E	LDX	↑	5	2	D3	ADDD	↑	6	2	1029	LBVS	↑	5(6)	4
9F	STX	Direct	5	2	D4	ANDB	↑	4	2	102A	LBPL	↑	5(6)	4
					D5	BITB	↑	4	2	102B	LBMI	↑	5(6)	4
A0	SUBA	Indexed	4+	2+	D6	LDB	↑	4	2	102C	LBGE	↑	5(6)	4
A1	CMPA	↑	4+	2+	D7	STB	↑	4	2	102D	LBLT	↑	5(6)	4
A2	SBCA	↑	4+	2+	D8	EORB	↑	4	2	102E	LBGT	↑	5(6)	4
A3	SUBD	↑	6+	2+	D9	ADCB	↑	4	2	102F	LBLE	Relative	5(6)	4
A4	ANDA	↑	4+	2+	DA	ORB	↑	4	2	103F	SWI2	Implied	20	2
A5	BITA	↑	4+	2+	DB	ADDB	↑	4	2	1083	CMPD	Immed	5	4
A6	LDA	↑	4+	2+	DC	LDD	↑	5	2	108C	CMPLY	↑	5	4
A7	STA	↑	4+	2+	DD	STD	↑	5	2	108E	LDY	Immed	4	4
A8	EORA	↑	4+	2+	DE	LDU	↑	5	2	1093	CMPD	Direct	7	3
A9	ADCA	↑	4+	2+	DF	STU	Direct	5	2	109C	CMPLY	↑	7	3
AA	ORA	↑	4+	2+			↑			109E	LDY	↑	6	3
AB	ADDA	↑	4+	2+	E0	SUBB	Indexed	4+	2+	109F	STY	Direct	6	3
AC	CMPX	↑	6+	2+	E1	CMPB	↑	4+	2+	10A3	CMPD	↑	7+	3+
AD	JSR	↑	7+	2+	E2	SBCB	↑	4+	2+	10AC	CMPLY	↑	7+	3+
AE	LDX	↑	5+	2+	E3	ADDD	↑	6+	2+	10AE	LDY	↑	6+	3+
AF	STX	Indexed	5+	2+	E4	ANDB	↑	4+	2+	10AF	STY	↑	6+	3+
					E5	BITB	↑	4+	2+	10B3	CMPD	Extended	8	4
B0	SUBA	Extended	5	3	E6	LDB	↑	4+	2+	10B8	LDY	↑	7	4
B1	CMPA	↑	5	3	E7	STB	↑	4+	2+	10BF	STY	Extended	7	4
B2	SBCA	↑	5	3	E8	EORB	↑	4+	2+	10CE	LDS	Immed	4	4
B3	SUBD	↑	7	3	E9	ADCB	↑	4+	2+	10DE	LDS	Direct	6	3
B4	ANDA	↑	5	3	EA	ORB	↑	4+	2+	10DF	STS	Direct	6	3
B5	BITA	↑	5	3	EB	ADDB	↑	4+	2+	10EE	LDS	Indexed	6+	3+
B6	LDA	↑	5	3	EC	LDD	↑	5+	2+	10EF	STS	Indexed	6+	3+
B7	STA	↑	5	3	ED	STD	↑	5+	2+	10FE	LDS	Extended	7	4
B8	EORA	↑	5	3	EE	LDU	↑	5+	2+	10FF	STS	Extended	7	4
B9	ADCA	↑	5	3	EF	STU	Indexed	5+	2+	113F	SWI3	Implied	20	2
BA	ORA	↑	5	3			↑			1183	CMPL	Immed	5	4
BB	ADDA	↑	5	3	F0	SUBB	Extended	5	3	118C	CMPS	Immed	5	4
BC	CMPX	↑	7	3	F1	CMPB	↑	5	3	1193	CMPL	Direct	7	3
BD	JSR	↑	8	3	F2	SBCB	↑	5	3	119C	CMPS	Direct	7	3
BE	LDX	↑	6	3	F3	ADDD	↑	5	3	11A3	CMPL	Indexed	7+	3+
BF	STX	Extended	6	3	F4	ANDB	↑	5	3	11AC	CMPS	Indexed	7+	3+
					F5	BITB	↑	5	3	11B3	CMPL	Extended	8	4
C0	SUBB	Immed	2	2	F6	LDB	↑	5	3	11BC	CMPS	Extended	8	4
C1	CMPB	↑	2	2	F7	STB	↑	5	3					
C2	SBCB	↑	2	2	F8	EORB	↑	5	3					
C3	ADDD	↑	4	3	F9	ADCB	↑	5	3					
C4	ANDB	↑	2	2	FA	ORB	↑	5	3					
C5	BITB	Immed	2	2	FB	ADDB	Extended	5	3					

(NOTE): All unused opcodes are both undefined and illegal

■ NOTE FOR USE

[1] Exceptional Operation of HD6809

(a) Exceptional Operations of $\overline{\text{DMA/BREQ}}$, BA signals (#1)

HD6809 acknowledges the input signal level of $\overline{\text{DMA/BREQ}}$ at the end of each cycle, then determines whether the next sequence is MPU or DMA. When "Low" level is detected, HD6809 executes DMA

sequence by setting BA, BS to "High" level. However, in the conditions shown below the assertion of BA, BS delays one clock cycle.

< Conditions for the exception >

- (1) $\overline{\text{DMA/BREQ}}$: "Low" for 6~13 cycles
- (2) $\overline{\text{DMA/BREQ}}$: "High" for 3 cycles

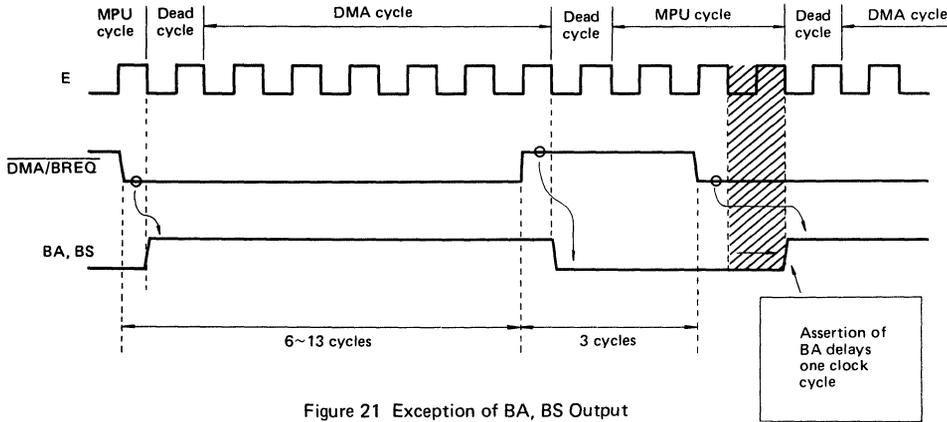


Figure 21 Exception of BA, BS Output

(b) Exceptional Operations of $\overline{\text{DMA/BREQ}}$, BA signals (#2)

HD6809 includes a self refresh counter for the re-

verse cycle steal. And it is only cleared if $\overline{\text{DMA/BREQ}}$ is inactive ("High") for 3 or more MPU cycles. So 1 or 2 inactive cycle(s) doesn't affect the self refresh counter.

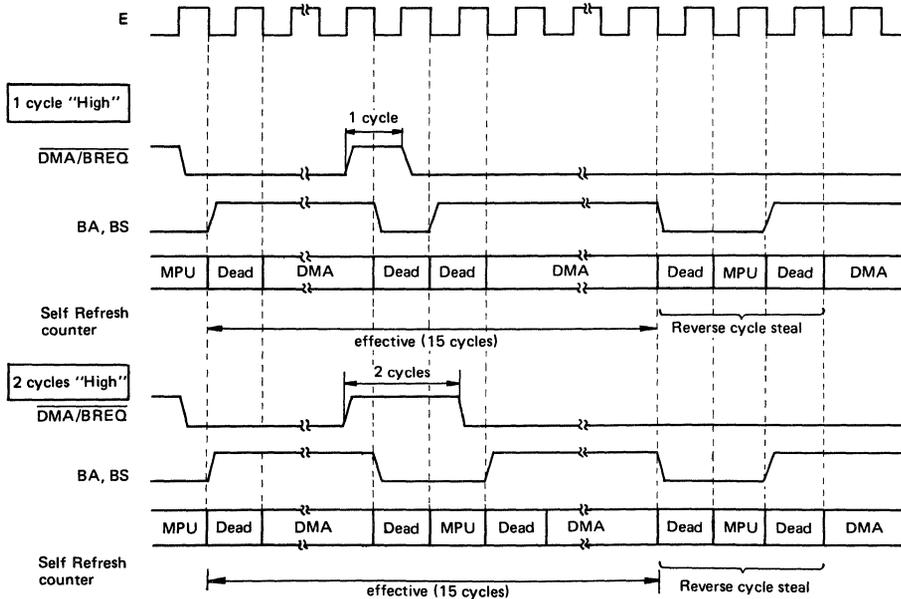


Figure 22 Exception of $\overline{\text{DMA/BREQ}}$

(c) **How to avoid these exceptional operations**

It is necessary to provide 4 or more cycles for in-

active $\overline{\text{DMA/BREQ}}$ level as shown in Fig. 23.

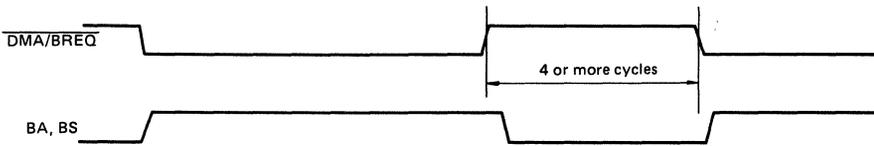


Figure 23 How to Avoid Exceptional Operations

[2] **Restriction for DMA Transfer**

There is a restriction for the DMA transfer in the HD6809 (MPU), HD6844 (DMAC) system. Please take care of following.

(a) **An Example of the System Configuration**

This restriction is applied to the following system.

- (1) $\overline{\text{DMA/BREQ}}$ is used for DMA request.
- (2) "Halt Burst Mode" is used for DMA transfer

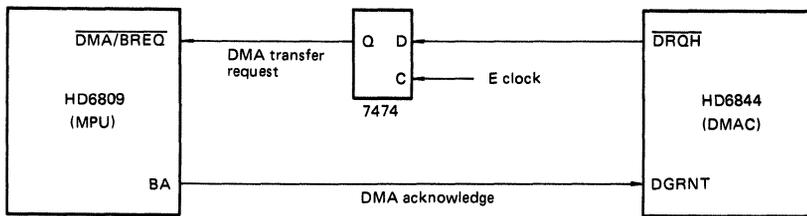


Figure 24 An Example of HD6809, HD6844 System

(The restriction is also applied to the system which doesn't use 7474 Flip-Flop. Fig. 24, Fig. 25 shows an example which uses 7474 for synchronizing DMA request with E.

(b) **Restriction**

"The number of transfer Byte per one DMA Burst transfer must be less than or equal to 14."

Halt burst DMA transfer should be less than or equal to 14 cycles. In another word, the number stored into DMA Byte count register should be 0~14.

★ Please than care of the section [1](b) if 2 or more DMA channels are used for the DMA transfer.

(c) **Incorrect operation of HD6809, HD6844 system**

"Incorrect Operation" will occur if the number of DMA transfer Byte is more than 14 bytes. If $\overline{\text{DMA/BREQ}}$ is kept in "Low" level HD6809 performs

reverse cycle steals once in 14 DMA cycles by taking back the bus control. In this case, however, the action taken by MPU is a little bit different from the DMAC.

As shown in Fig. 25, DMA controller can't stop DMA transfer (A) by BA falling edge and excutes an extra DMA cycle during HD6809 dead cycle. So MPU cycle is excuted right after DMA cycle, the Bus confliction occurs at the beginning of MPU cycle.

(d) **How to impliment Halt Bust DMA transfer (> 14 cycles)**

Please use HALT input of HD6809 for the DMA request instead of $\overline{\text{DMA/BREQ}}$.

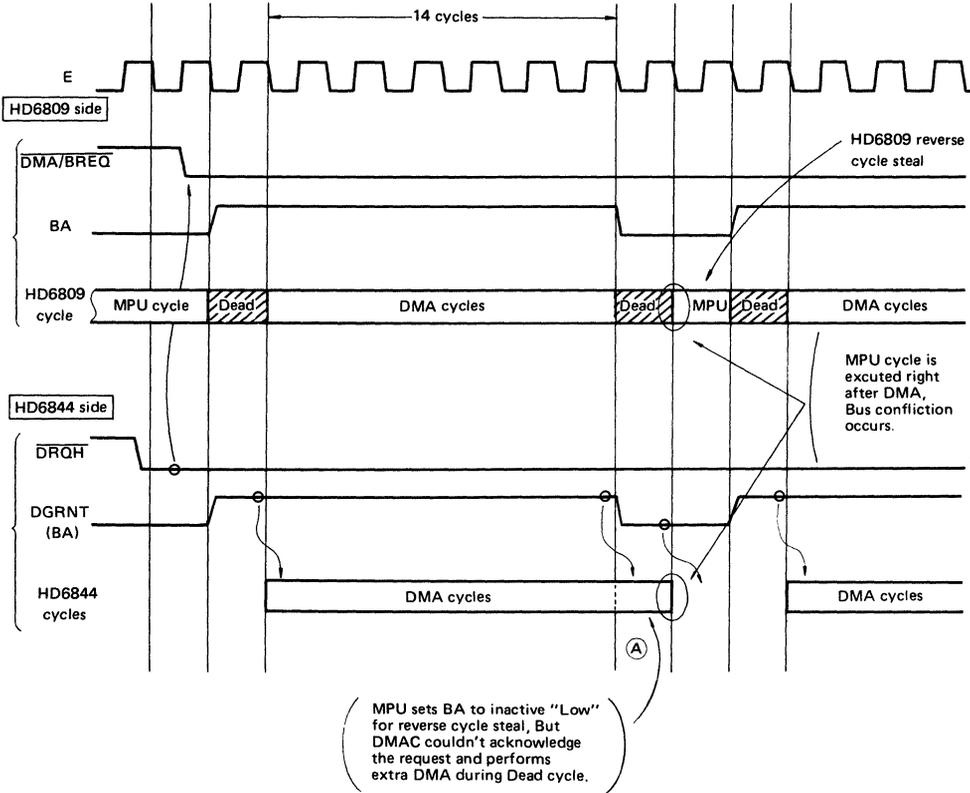


Figure 25 Comparison of HD6809, HD6844 DMA cycles

[3] Note for CLR Instruction

Cycle-by-cycle flow of CLR instruction (Direct, Extended, Indexed Addressing Mode) is shown below. In this sequence the content of the memory location specified by the operand is read before writing "00" into it. Note that status Flags, such as IRQ Flag, will be cleared by this extra data read operation when accessing the control/status register (sharing the same address between read and write) of peripheral devices.

Example: CLR (Extended)

Cycle #	Address	Data	R/W	Description
	\$8000	CLR		
	\$A000	FCB		
1	8000	7F	1	Opcode Fetch
2	8001	A0	1	Operand Address, High Byte
3	8002	00	1	Operand Address, Low Byte
4	FFFF	*	1	VMA Cycle
5	A000	80	1	Read the Data
6	FFFF	*	1	VMA Cycle
7	A000	00	0	Store Fixed "00" into Specified Location

* The data bus has the data at that particular address.

HD6309

CMOS MPU (Micro Processing Unit)

—ADVANCE INFORMATION—

The HD6309 is the highest 8-bit microprocessor of HMCS6800 family, which is just compatible with the conventional HD6809.

The HD6309 has hardware and software features which make it an ideal processor for higher level language execution or standard controller applications.

The HD6309 is complete CMOS device and the power dissipation is extremely low. Moreover the SYNC and CWAI instruction makes lower power application possible.

■ FEATURES

- Hardware — Interfaces with All HMCS6800 Peripherals
 - DMA transfer with no auto-refresh cycle
 - L in-Limited MRDY control
- Software — Fully Compatible with HD6809, HD6809E, HD6309E MPU families
- Low Power Consumption Mode; SYNC and CWAI instruction
- Crystal Oscillation
- Wide Operation Range
 - f = 0.5 to 8 MHz
 - (V_{CC} = 5V±10%)

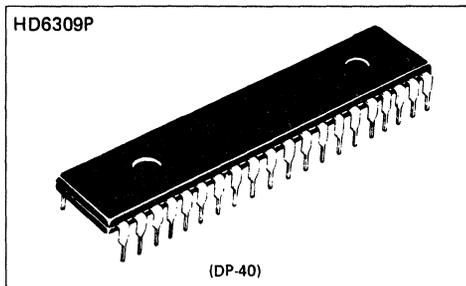
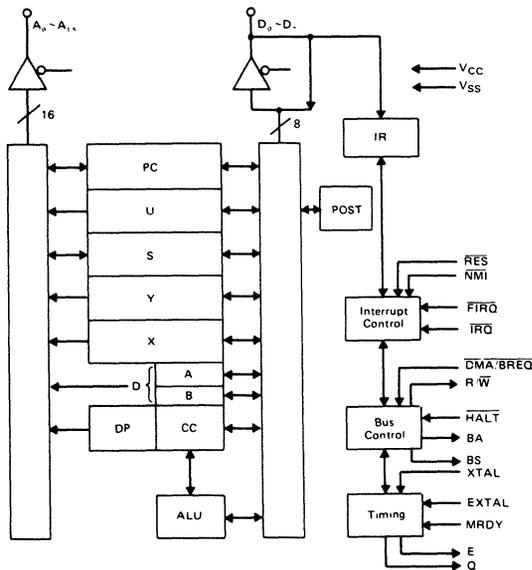
Bus Timing

2.0 MHz

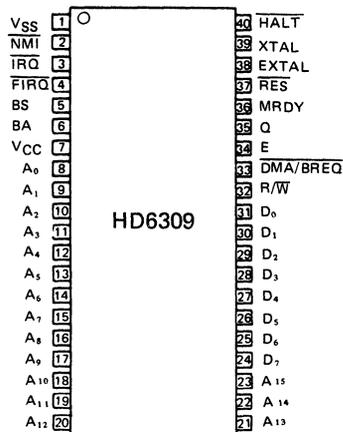
2.5 MHz

3.0 MHz

■ BLOCK DIAGRAM



■ PIN ARRANGEMENT



(Top View)

HD6809E, HD68A09E, HD68B09E MPU (Micro Processing Unit)

The HD6809E is a revolutionary high performance 8-bit microprocessor which supports modern programming techniques such as position independence, reentrancy, and modular programming.

This third-generation addition to the HMCS6800 family has major architectural improvements which include additional registers, instructions and addressing modes.

The basic instructions of any computer are greatly enhanced by the presence of powerful addressing modes. The HD6809E has the most complete set of addressing modes available on any 8-bit microprocessor today.

The HD6809E has hardware and software features which make it an ideal processor for higher level language execution or standard controller applications. External clock inputs are provided to allow synchronization with peripherals, systems or other MPUs.

HD6800 COMPATIBLE

- Hardware — Interfaces with All HMCS6800 Peripherals
- Software — Upward Source Code Compatible Instruction Set and Addressing Modes

ARCHITECTURAL FEATURES

- Two 16-bit Index Registers
- Two 16-bit Indexable Stack Pointers
- Two 8-bit Accumulators can be Concatenated to Form One 16-Bit Accumulator
- Direct Page Register Allows Direct Addressing Throughout Memory

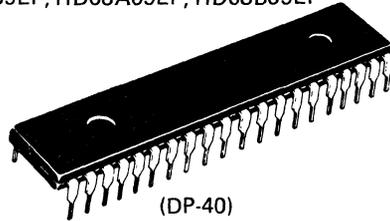
HARDWARE FEATURES

- External Clock Inputs, E and Q, Allow Synchronization
- TSC Input Controls Internal Bus Buffers
- LIC Indicates Opcode Fetch
- AVMA Allows Efficient Use of Common Resources in A Multiprocessor System
- BUSY is a Status Line for Multiprocessing
- Fast Interrupt Request Input Stacks Only Condition Code Register and Program Counter
- Interrupt Acknowledge Output Allows Vectoring By Devices
- SYNC Acknowledge Output Allows for Synchronization to External Event
- Single Bus-Cycle RESET
- Single 5-Volt Supply Operation
- NMI Blocked After RESET Until After First Load of Stack Pointer
- Early Address Valid Allows Use With Slower Memories
- Early Write-Data for Dynamic Memories

SOFTWARE FEATURES

- 10 Addressing Modes
 - HMCS6800 Upward Compatible Addressing Modes
 - Direct Addressing Anywhere in Memory Map
 - Long Relative Branches
 - Program Counter Relative
 - True Indirect Addressing
 - Expanded Indexed Addressing:
 - 0, 5, 8, or 16-bit Constant Offsets
 - 8, or 16-bit Accumulator Offsets

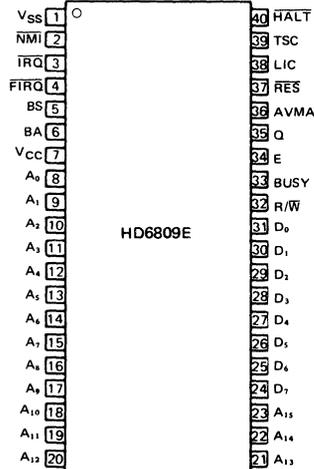
HD6809EP, HD68A09EP, HD68B09EP



Auto-Increment/Decrement by 1 or 2

- Improved Stack Manipulation
- 1464 Instruction with Unique Addressing Modes
- 8 x 8 Unsigned Multiply
- 16-bit Arithmetic
- Transfer/Exchange All Registers
- Push/Pull Any Registers or Any Set of Registers
- Load Effective Address

PIN ARRANGEMENT



(Top View)

■ ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Value	Unit
Supply Voltage	Vcc*	-0.3 ~ +7.0	V
Input Voltage	Vin*	-0.3 ~ +7.0	V
Operating Temperature Range	Topr	-20 ~ +75	°C
Storage Temperature Range	Tstg	-55 ~ +150	°C

* With respect to Vss (SYSTEM GND)

(NOTE) Permanent LSI damage may occur if maximum ratings are exceeded. Normal operation should be under recommended operating conditions. If these conditions are exceeded, it could affect reliability of LSI.

■ RECOMMENDED OPERATING CONDITIONS

Item	Symbol	min	typ	max	unit	
Supply Voltage	Vcc*	4.75	5.0	5.25	V	
Input Voltage	Logic, Q, \overline{RES}	VIL*	-	0.8	V	
	E	VILC*	-	0.4	V	
	Logic	VIH*	2.2	-	Vcc*	V
			4.0	-	Vcc*	V
	E	VIHC*	Vcc* - 0.75	-	Vcc* + 0.3	V
Operating Temperature	Topr	-20	25	75	°C	

* With respect to Vss (SYSTEM GND)

■ ELECTRICAL CHARACTERISTICS

● DC CHARACTERISTICS (VCC = 5.0V ±5%, VSS = 0V, Ta = -20 ~ +75°C, unless otherwise noted.)

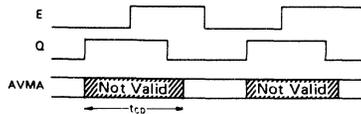
Item	Symbol	Test Condition	HD6809E			HD68A09E			HD68B09E			Unit
			min	typ*	max	min	typ*	max	min	typ*	max	
Input "High" Voltage	Logic, Q	VIH	2.2	-	Vcc	2.2	-	Vcc	2.2	-	Vcc	V
	\overline{RES}	VIHR	4.0	-	Vcc	4.0	-	Vcc	4.0	-	Vcc	V
	E	VIHC	Vcc - 0.75	-	Vcc + 0.3	Vcc - 0.75	-	Vcc + 0.3	Vcc - 0.75	-	Vcc + 0.3	V
Input "Low" Voltage	Logic, Q, \overline{RES}	VIL	-0.2	-	0.8	-0.2	-	0.8	-0.2	-	0.8	V
	E	VILC	-0.3	-	0.4	-0.3	-	0.4	-0.3	-	0.4	V
Input Leakage Current	Logic, Q, \overline{RES}	Iin	Vin = 0 ~ 5.25V, Vcc = max		-2.5	2.5	-2.5	2.5	-2.5	2.5	μA	
	E		-100	100	-100	100	-100	100	μA			
Output "High" Voltage	D0 ~ D7	VOH	I _{Load} = -205μA, Vcc = min		2.4	-	2.4	-	2.4	-	V	
	A0 ~ A15, R/W		I _{Load} = -145μA, Vcc = min		2.4	-	2.4	-	2.4	-	V	
	BA, BS, LIC, AVMA, BUSY		I _{Load} = -100μA, Vcc = min		2.4	-	2.4	-	2.4	-	V	
Output "Low" Voltage	VOL	I _{Load} = 2mA, Vcc = min		-	0.5	-	0.5	-	0.5	V		
Power Dissipation	PD			-	1.0	-	1.0	-	1.0	W		
Input Capacitance	D0 ~ D7, Logic Input, Q, \overline{RES}	Cin	Vin = 0V, Ta = 25°C, f = 1MHz		-	10	-	10	-	10	pF	
	E		-	30	-	30	-	30	-	30	pF	
Output Capacitance	A0 ~ A15, R/W, BA, BS, LIC, AVMA, BUSY	Cout	Vin = 0V, Ta = 25°C, f = 1MHz		-	10	-	10	-	10	pF	
Frequency of Operation	E, Q	f	0.1	-	1.0	0.1	-	1.5	0.1	-	2.0	MHz
Three-State (Off State) Input Current	D0 ~ D7	I _{TSI}	Vin = 0.4 ~ 2.4V, Vcc = max		-10	-	10	-10	-	10	μA	
	A0 ~ A15, R/W		-100	100	-100	100	-100	100	μA			

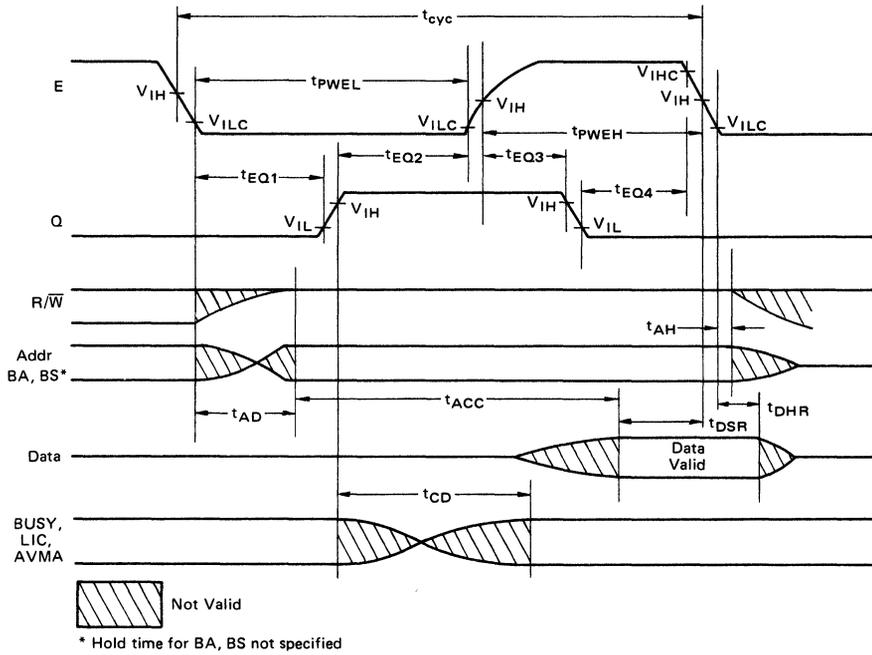
* Ta = 25°C, VCC = 5V

● AC CHARACTERISTICS (V_{CC} = 5.0V ±5%, V_{SS} = 0V, T_a = -20 ~ +75°C, unless otherwise noted.)
READ/WRITE TIMING

Item	Symbol	Test Condition	HD6809E			HD68A09E			HD68B09E			Unit	
			min	typ	max	min	typ	max	min	typ	max		
Cycle Time	t _{cyc}	Fig. 1, 2, 7 ~ 10, 14 and 17	1000	—	10000	667	—	10000	500	—	10000	ns	
Peripheral Read Access Times t _{cyc} - t _{Ef} - t _{AD} - t _{DSR} = t _{ACC}	t _{ACC}		695	—	—	440	—	—	330	—	—	ns	
Data Setup Time (Read)	t _{DSR}		80	—	—	60	—	—	40	—	—	ns	
Input Data Hold Time	t _{DHR}		10	—	—	10	—	—	10	—	—	ns	
Output Data Hold Time	t _{DHW}		T _a = 0 ~ +75°C	30	—	—	30	—	—	30	—	—	ns
			T _a = -20 ~ 0°C	20	—	—	20	—	—	20	—	—	ns
Address Hold Time (Address, R/W)	t _{AH}		T _a = 0 ~ +75°C	20	—	—	20	—	—	20	—	—	ns
			T _a = -20 ~ 0°C	10	—	—	10	—	—	10	—	—	ns
Address Delay	t _{AD}		—	—	200	—	—	140	—	—	120	ns	
Data Delay Time (Write)	t _{DDW}		—	—	200	—	—	140	—	—	110	ns	
E Clock "Low"	t _{PWEL}		450	—	9500	295	—	9500	210	—	9500	ns	
E Clock "High" (Measured at V _{IH})	t _{PWEH}		450	—	9500	280	—	9500	220	—	9500	ns	
E Rise and Fall Time	t _{Er} , t _{Ef}		—	—	25	—	—	25	—	—	20	ns	
Q Clock "High"	t _{PWQH}		450	—	9500	280	—	9500	220	—	9500	ns	
Q Rise and Fall Time	t _{Qr} , t _{Qf}		—	—	25	—	—	25	—	—	20	ns	
E "Low" to Q Rising	t _{EQ1}		200	—	—	130	—	—	100	—	—	ns	
Q "High" to E Rising	t _{EQ2}		200	—	—	130	—	—	100	—	—	ns	
E "High" to Q Falling	t _{EQ3}		200	—	—	130	—	—	100	—	—	ns	
Q "Low" to E Falling	t _{EQ4}		200	—	—	130	—	—	100	—	—	ns	
Interrupts HALT, RES and TSC Setup Time	t _{PCS}		200	—	—	140	—	—	110	—	—	ns	
TSC Drive to Valid Logic Levels	t _{TSA}		—	—	210	—	—	150	—	—	120	ns	
TSC Release MOS Buffers to High Impedance	t _{TSR}		—	—	200	—	—	140	—	—	110	ns	
TSC Three-State Delay	t _{TSD}		—	—	120	—	—	85	—	—	80	ns	
Control Delay (BUSY, LIC)	t _{CD}		—	—	300	—	—	250	—	—	200	ns	
Control Delay (AVMA*)	t _{CD}		—	—	300	—	—	270	—	—	240	ns	
Processor Control Rise/Fall	t _{PCr} , t _{PCf}		—	—	100	—	—	100	—	—	100	ns	
TSC Input Delay	t _{PCT}		10	—	—	10	—	—	10	—	—	ns	

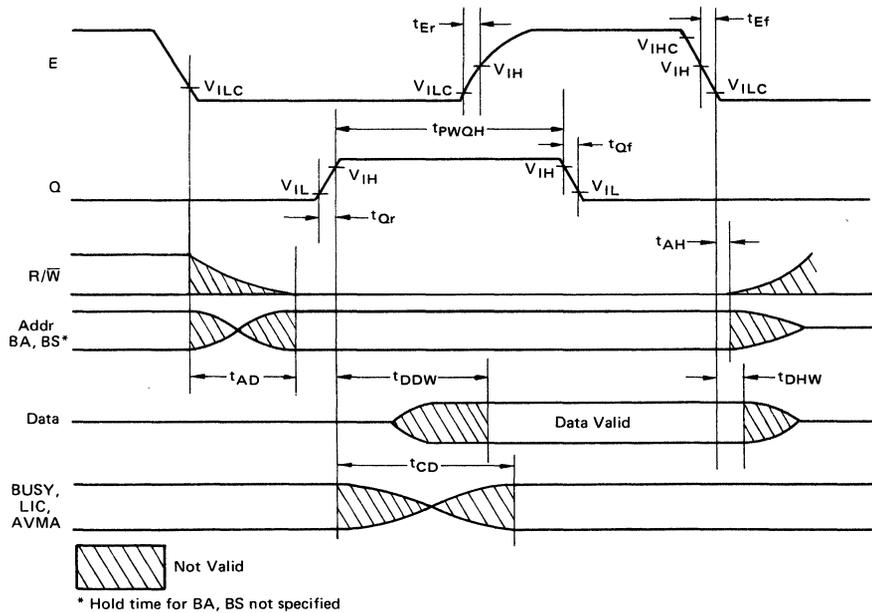
* AVMA drives a not-valid data before providing correct output, so spec t_{CD max} = 270 nsec (HD68A09E) and 240 nsec (HD68B09E) are applied to this signal. When this delay time causes a problem in user's application, please use D-type latch to get stable output.





(NOTE) Waveform measurements for all inputs and outputs are specified at logic "High" = V_{IHmin} and logic "Low" = V_{ILmax} unless otherwise specified.

Figure 1 Read Data from Memory or Peripherals



(NOTE) Waveform measurements for all inputs and outputs are specified at logic "High" = V_{IHmin} and logic "Low" = V_{ILmax} unless otherwise specified.

Figure 2 Write Data to Memory or Peripherals

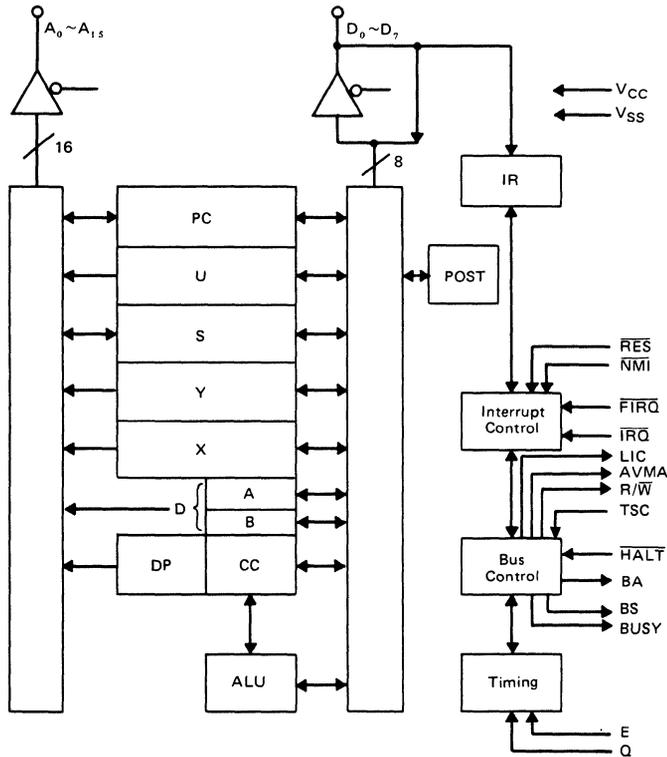
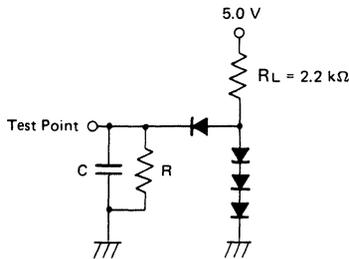


Figure 3 HD6809E Expanded Block Diagram



C = 30 pF for BA, BS, LIC, AVMA, BUSY
 130 pF for D₀ ~ D₇
 90 pF for A₀ ~ A₁₅, R/W
 R = 11.7 kΩ for D₀ ~ D₇
 16.5 kΩ for A₀ ~ A₁₅, R/W
 24 kΩ for BA, BS, LIC, AVMA, BUSY

All diodes are 1S2074(H) or equivalent.
 C includes stray capacitance.

Figure 4 Bus Timing Test Load

■ PROGRAMMING MODEL

As shown in Figure 5, the HD6809E adds three registers to the set available in the HD6800. The added registers include a Direct Page Register, the User Stack pointer and a second Index Register.

● Accumulators (A, B, D)

The A and B registers are general purpose accumulators which are used for arithmetic calculations and manipulation of data.

Certain instructions concatenate the A and B registers to form a single 16-bit accumulator. This is referred to as the D Register, and is formed with the A Register as the most significant byte.

● Direct Page Register (DP)

The Direct Page Register of the HD6809E serves to enhance the Direct Addressing Mode. The content of this register appears at the higher address outputs (A₈ ~ A₁₅) during direct addressing instruction execution. This allows the direct mode to be used at any place in memory, under program control. To ensure HD6800 compatibility, all bits of this register are cleared during Processor Reset.

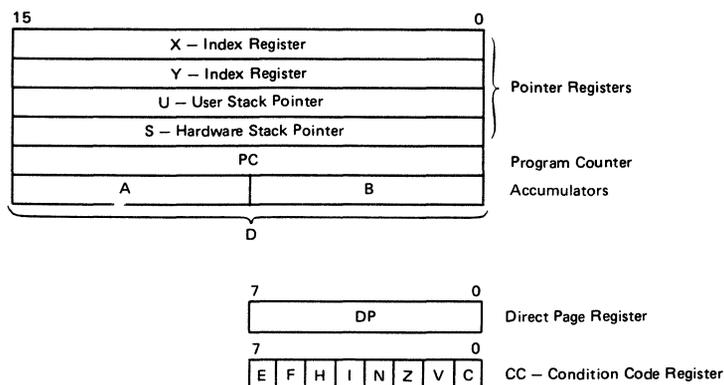


Figure 5 Programming Model of The Microprocessing Unit

● **Index Registers (X, Y)**

The Index Registers are used in indexed mode of addressing. The 16-bit address in this register takes part in the calculation of effective addresses. This address may be used to point to data directly or may be modified by an optional constant or register offset. During some indexed modes, the contents of the index register are incremented or decremented to point to the next item of tabular type data. All four pointer registers (X, Y, U, S) may be used as index registers.

● **Stack Pointer (U, S)**

The Hardware Stack Pointer (S) is used automatically by the processor during subroutine calls and interrupts. The User Stack Pointer (U) is controlled exclusively by the programmer thus allowing arguments to be passed to and from subroutines with ease. The U-register is frequently used as a stack marker. Both Stack Pointers have the same indexed mode addressing capabilities as the X and Y registers, but also support **Push** and **Pull** instructions. This allows the HD6809E to be used efficiently as a stack processor, greatly enhancing its ability to support higher level languages and modular programming.

(NOTE) The stack pointers of the HD6809E point to the top of the stack, in contrast to the HD6800 stack pointer, which pointed to the next free location on stack.

● **Program Counter (PC)**

The Program Counter is used by the processor to point to the address of the next instruction to be executed by the processor. Relative Addressing is provided allowing the Program Counter to be used like an index register in some situations.

● **Condition Code Register (CC)**

The Condition Code Register defines the state of the processor at any given time. See Figure 6.

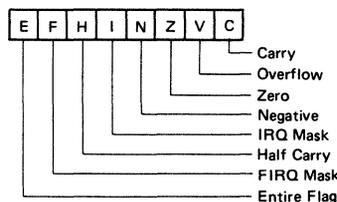


Figure 6 Condition Code Register Format

■ **CONDITION CODE REGISTER DESCRIPTION**

● **Bit 0 (C)**

Bit 0 is the carry flag, and is usually the carry from the binary ALU. C is also used to represent a 'borrow' from subtract like instructions (CMP, NEG, SUB, SBC) and is the complement of the carry from the binary ALU.

● **Bit 1 (V)**

Bit 1 is the overflow flag, and is set to a one by an operation which causes a signed two's complement arithmetic overflow. This overflow is detected in an operation in which the carry from the MSB in the ALU does not match the carry from the MSB-1.

● **Bit 2 (Z)**

Bit 2 is the zero flag, and is set to a one if the result of the previous operation was identically zero.

● **Bit 3 (N)**

Bit 3 is the negative flag, which contains exactly the value of the MSB of the result of the preceding operation. Thus, a negative two's-complement result will leave N set to a one.

• **Bit 4 (I)**

Bit 4 is the $\overline{\text{IRQ}}$ mask bit. The processor will not recognize interrupts from the $\overline{\text{IRQ}}$ line if this bit is set to a one. $\overline{\text{NMI}}$, $\overline{\text{FIRQ}}$, $\overline{\text{IRQ}}$, $\overline{\text{RES}}$ and $\overline{\text{SWI}}$ all set I to a one; $\overline{\text{SWI2}}$ and $\overline{\text{SWI3}}$ do not affect I.

• **Bit 5 (H)**

Bit 5 is the half-carry bit, and is used to indicate a carry from bit 3 in the ALU as a result of an 8-bit addition only (ADC or ADD). This bit is used by the DAA instruction to perform a BCD decimal add adjust operation. The state of this flag is undefined in all subtract-like instructions.

• **Bit 6 (F)**

Bit 6 is the $\overline{\text{FIRQ}}$ mask bit. The processor will not recognize interrupts from the $\overline{\text{FIRQ}}$ line if this bit is a one. $\overline{\text{NMI}}$, $\overline{\text{FIRQ}}$, $\overline{\text{SWI}}$, and $\overline{\text{RES}}$ all set F to a one. $\overline{\text{IRQ}}$, $\overline{\text{SWI2}}$ and $\overline{\text{SWI3}}$ do not affect F.

• **Bit 7 (E)**

Bit 7 is the entire flag, and when set to a one indicates that the complete machine state (all the registers) was stacked, as opposed to the subset state (PC and CC). The E bit of the stacked CC is used on a return from interrupt (RTI) to determine the extent of the unstacking. Therefore, the current E left in the Condition Code Register represents past action.

■ **HD6809E MPU SIGNAL DESCRIPTION**

• **Power (VSS, VCC)**

Two pins are used to supply power to the part: VSS is ground or 0 volts, while VCC is +5.0 V $\pm 5\%$.

• **Address Bus (A₀ ~ A₁₅)**

Sixteen pins are used to output address information from the MPU onto the Address Bus. When the processor does not require the bus for a data transfer, it will output address FFFF₁₆, $\overline{\text{R/W}}$ = "High", and BS = "Low"; this is a "dummy access" or VMA cycle. All address bus drivers are made high-impedance when output Bus Available (BA) is "High" or when TSC is asserted. Each pin will drive one Schottky TTL load or four LS TTL loads, and 90 pF. Refer to Figures 1 and 2.

• **Data Bus (D₀ ~ D₇)**

These eight pins provide communication with the system bi-directional data bus. Each pin will drive one Schottky TTL load or four LS TTL loads, and 130 pF.

• **Read/Write (R/ $\overline{\text{W}}$)**

This signal indicates the direction of data transfer on the data bus. A "Low" indicates that the MPU is writing data onto the data bus. $\overline{\text{R/W}}$ is made high impedance when BA is "High" or when TSC is asserted. Refer to Figures 1 and 2.

• **RES**

A "Low" level on this Schmitt-trigger input for greater than one bus cycle will reset the MPU, as shown in Figure 7. The Reset vectors are fetched from locations FFFE₁₆ and FFFF₁₆ (Table 1) when Interrupt Acknowledge is true, ($\overline{\text{BA}} \cdot \text{BS} = 1$). During initial power-on, the Reset line should be held "Low" until the clock input signals are fully operational.

Because the HD6809E Reset pin has a Schmitt-trigger input with a threshold voltage higher than that of standard peripherals, a simple R/C network may be used to reset the entire system.

This higher threshold voltage ensures that all peripherals are out of the reset state before the Processor.

Table 1 Memory Map for Interrupt Vectors

Memory Map for Vector Locations		Interrupt Vector Description
MS	LS	
FFFE	FFFF	$\overline{\text{RES}}$
FFFC	FFFD	$\overline{\text{NMI}}$
FFFA	FFFB	$\overline{\text{SWI}}$
FFF8	FFF9	$\overline{\text{IRQ}}$
FFF6	FFF7	$\overline{\text{FIRQ}}$
FFF4	FFF5	$\overline{\text{SWI2}}$
FFF2	FFF3	$\overline{\text{SWI3}}$
FFF0	FFF1	Reserved

• **HALT**

A "Low" level on this input pin will cause the MPU to stop running at the end of the present instruction and remain halted indefinitely without loss of data. When halted, the BA output is driven "High" indicating the buses are high impedance. BS is also "High" which indicates the processor is in the Halt state. While halted, the MPU will not respond to external real-time requests ($\overline{\text{FIRQ}}$, $\overline{\text{IRQ}}$) although $\overline{\text{NMI}}$ or $\overline{\text{RES}}$ will be latched for later response. During the Halt state Q and E should continue to run normally. A halted state ($\text{BA} \cdot \text{BS} = 1$) can be achieved by pulling $\overline{\text{HALT}}$ "Low" while $\overline{\text{RES}}$ is still "Low". See Figure 8.

• **Bus Available, Bus Status (BA, BS)**

The Bus Available output is an indication of an internal control signal which makes the MOS buses of the MPU high impedance. When BA goes "Low", a dead cycle will elapse before the MPU acquires the bus. BA will not be asserted when TSC is active, thus allowing dead cycle consistency.

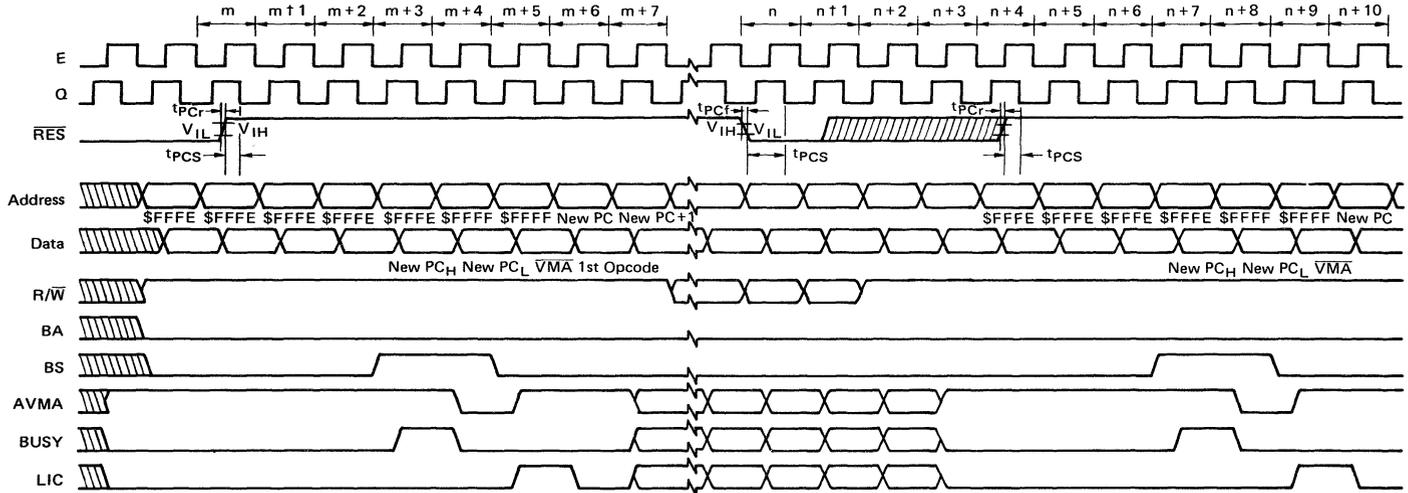
The Bus Status output signal, when decoded with BA, represents the MPU state (valid with leading edge of Q).

MPU State		MPU State Definition
BA	BS	
0	0	Normal (Running)
0	1	Interrupt or RESET Acknowledge
1	0	SYNC Acknowledge
1	1	HALT Acknowledge

Interrupt Acknowledge is indicated during both cycles of a hardware-vector-fetch ($\overline{\text{RES}}$, $\overline{\text{NMI}}$, $\overline{\text{FIRQ}}$, $\overline{\text{IRQ}}$, $\overline{\text{SWI}}$, $\overline{\text{SWI2}}$, $\overline{\text{SWI3}}$). This signal, plus decoding of the lower four address lines, can provide the user with an indication of which interrupt level is being serviced and allow vectoring by device. See Table 1.

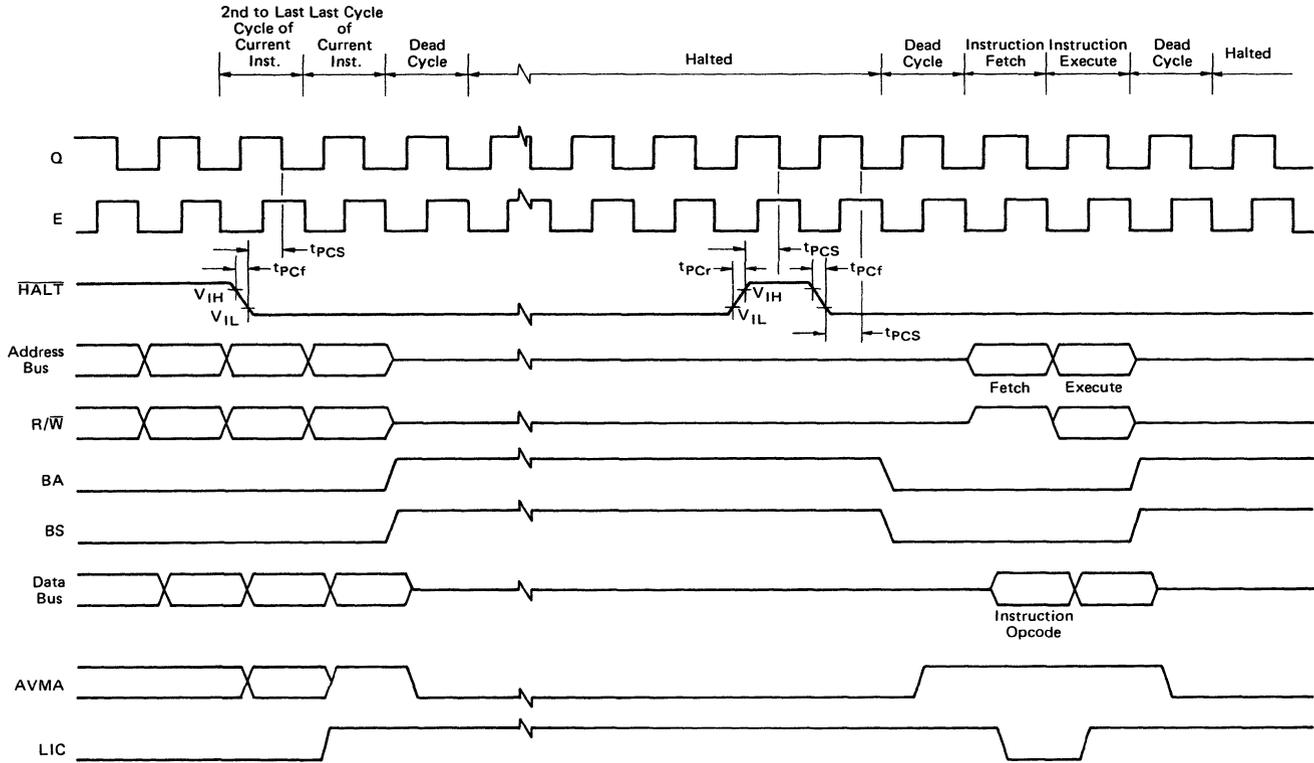
Sync Acknowledge is indicated while the MPU is waiting for external synchronization on an interrupt line.

Halt Acknowledge is indicated when the HD6809E is in a Halt condition.



(NOTE) Waveform measurements for all inputs and outputs are specified at logic "High" = V_{IHmin} and logic "Low" = V_{ILmax} unless otherwise specified.

Figure 7 \overline{RES} Timing



(NOTE) Waveform measurements for all inputs and outputs are specified at logic "High" = V_{IHmin} and logic "Low" = V_{ILmax} unless otherwise specified.

Figure 8 \overline{HALT} and Single Instruction Execution for System Debug

- **Non Maskable Interrupt ($\overline{\text{NMI}}$)***

A negative transition on this input requests that a non-maskable interrupt sequence be generated. A non-maskable interrupt cannot be inhibited by the program, and also has a higher priority than $\overline{\text{FIRQ}}$, $\overline{\text{IRQ}}$ or software interrupts. During recognition of an $\overline{\text{NMI}}$, the entire machine state is saved on the hardware stack. After reset, an $\overline{\text{NMI}}$ will not be recognized until the first program load of the Hardware Stack Pointer (S). The pulse width of $\overline{\text{NMI}}$ low must be at least one E cycle. If the $\overline{\text{NMI}}$ input does not meet the minimum set up with respect to Q, the interrupt will not be recognized until the next cycle. See Figure 9.

- **Fast-Interrupt Request ($\overline{\text{FIRQ}}$)***

A "Low" level on this input pin will initiate a fast interrupt sequence, provided its mask bit (F) in the CC is clear. This sequence has priority over the standard Interrupt Request ($\overline{\text{IRQ}}$), and is fast in the sense that it stacks only the contents of the condition code register and the program counter. The interrupt service routine should clear the source of the interrupt before doing an RTI. See Figure 10.

- **Interrupt Request ($\overline{\text{IRQ}}$)***

A "Low" level input on this pin will initiate an Interrupt Request sequence provided the mask bit (I) in the CC is clear. Since $\overline{\text{IRQ}}$ stacks the entire machine state it provides a slower response to interrupts than $\overline{\text{FIRQ}}$. $\overline{\text{IRQ}}$ also has a lower priority than $\overline{\text{FIRQ}}$. Again, the interrupt service routine should clear the source of the interrupt before doing an RTI. See Figure 9.

* $\overline{\text{NMI}}$, $\overline{\text{FIRQ}}$, and $\overline{\text{IRQ}}$ requests are sampled on the falling edge of Q. One cycle is required for synchronization before these interrupts are recognized. The pending interrupt(s) will not be serviced until completion of the current instruction unless a SYNC or CWA condition is present. If $\overline{\text{IRQ}}$ and $\overline{\text{FIRQ}}$ do not remain "Low" until completion of the current instruction they may not be recognized. However, $\overline{\text{NMI}}$ is latched and need only remain "Low" for one cycle.

- **Clock Inputs E, Q**

E and Q are the clock signals required by the HD6809E. Q must lead E; that is, a transition on Q must be followed by a similar transition on E after a minimum delay. Addresses will be valid from the MPU, t_{AD} after the falling edge of E, and data will be latched from the bus by the falling edge of E. While the Q input is fully TTL compatible, the E input directly drives internal MOS circuitry and, thus, requires levels above normal TTL levels. This approach minimizes clock skew inherent with an internal buffer. Timing and waveforms for E and Q are shown in Figures 1 and 2 while Figure 11 shows a simple clock generator for the HD6809E.

- **BUSY**

Busy will be "High" for the read and modify cycles of a read-modify-write instruction and during the access of the first byte

of a double-byte operation (e.g., LDX, STD, ADDD). Busy is also "High" during the first byte of any indirect or other vector fetch (e.g., jump extended, SWI indirect etc.).

In a multi-processor system, busy indicates the need to defer the re arbitration of the next bus cycle to insure the integrity of the above operations. This difference provides the indivisible memory access required for a "test-and-set" primitive, using any one of several read-modify-write instructions.

Busy does not become active during PSH or PUL operations. A typical read-modify-write instruction (ASL) is shown in Figure 12. Timing information is given in Figure 13. Busy is valid t_{CD} after the rising edge of Q.

- **AVMA**

AVMA is the Advanced VMA signal and indicates that the MPU will use the bus in the following bus cycle. The predictive nature of the AVMA signal allows efficient shared-bus multi-processor systems. AVMA is "Low" when the MPU is in either a HALT or SYNC state. AVMA is valid t_{CD} after the rising edge of Q.

- **LIC**

LIC (Last Instruction Cycle) is "High" during the last cycle of every instruction, and its transition from "High" to "Low" will indicate that the first byte of an opcode will be latched at the end of the present bus cycle. LIC will be "High" when the MPU is Halted at the end of an instruction, (i.e., not in CWA or RESET) in SYNC state or while stacking during interrupts. LIC is valid t_{CD} after the rising edge of Q.

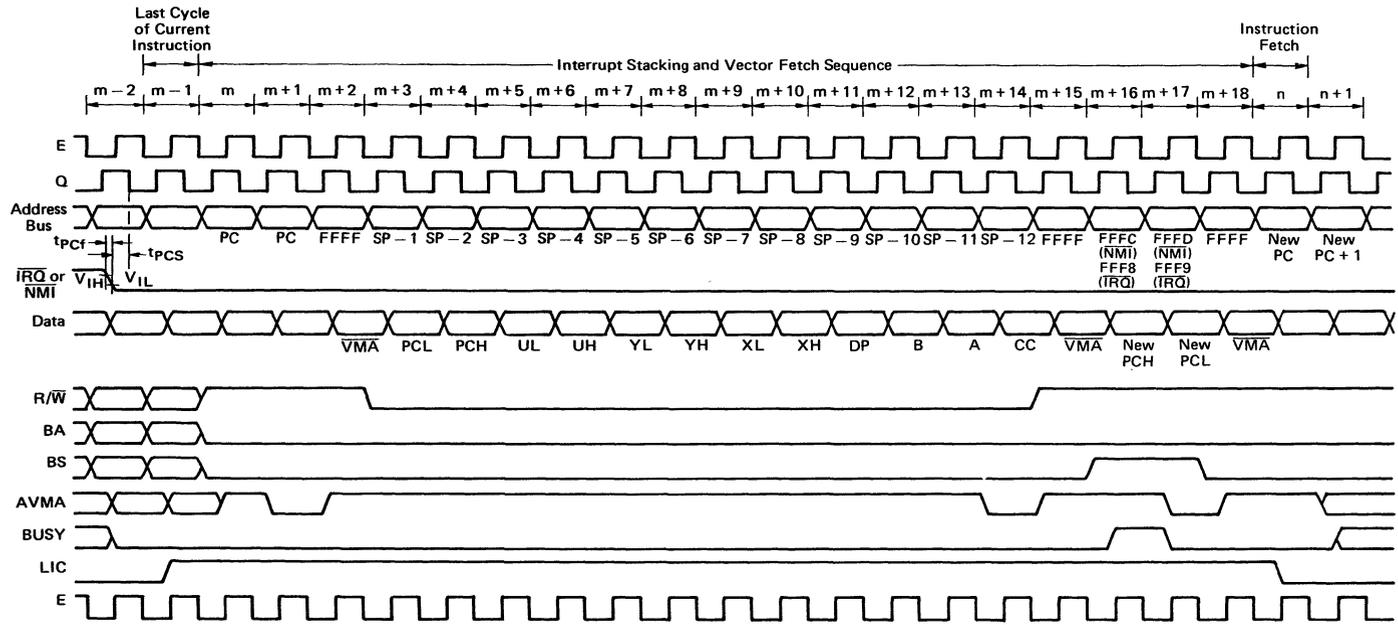
- **TSC**

TSC (Three-State Control) will cause MOS address, data, and R/W buffers to assume a high-impedance state. The control signals (BA, BS, BUSY, AVMA and LIC) will not go to the high-impedance state. TSC is intended to allow a single bus to be shared with other bus masters (processors or DMA controllers).

While E is "Low", TSC controls the address buffers and R/W directly. The data bus buffers during a write operation are in a high-impedance state until Q rises at which time, if TSC is true, they will remain in a high-impedance state. If TSC is held beyond the rising edge of E, then it will be internally latched, keeping the bus drivers in a high-impedance state for the remainder of the bus cycle. See Figure 14.

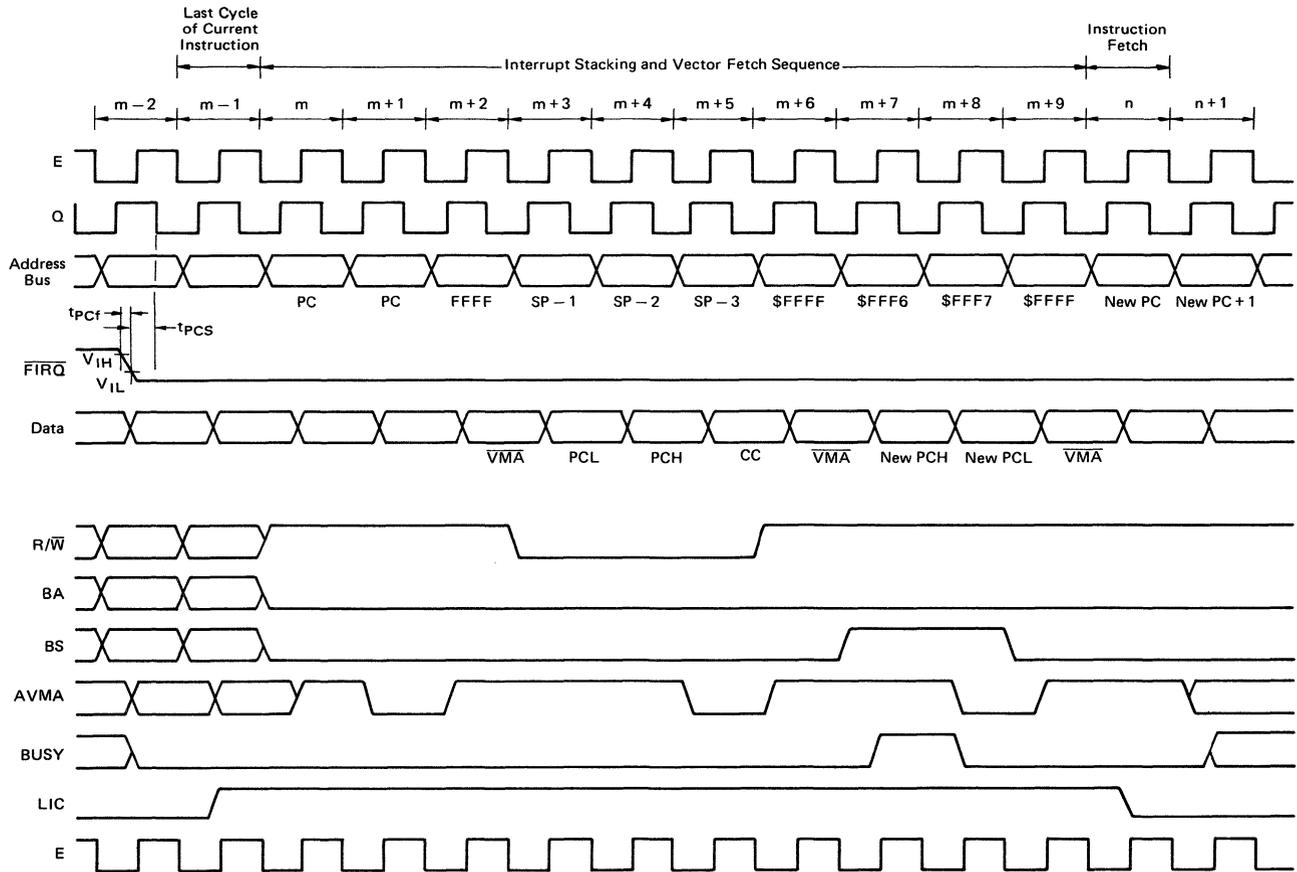
- **MPU Operation**

During normal operation, the MPU fetches an instruction from memory and then executes the requested function. This sequence begins after $\overline{\text{RES}}$ and is repeated indefinitely unless altered by a special instruction or hardware occurrence. Software instructions that alter normal MPU operation are: $\overline{\text{SWI}}$, $\overline{\text{SWI2}}$, $\overline{\text{SWI3}}$, CWA, RTI and SYNC. An interrupt or HALT input can also alter the normal execution of instructions. Figure 15 illustrates the flow chart for the HD6809E.



(NOTE) Waveform measurements for all inputs and outputs are specified at logic "High" = V_{IHmin} and logic "Low" = V_{ILmax} unless otherwise specified. E clock shown for reference only.

Figure 9 \overline{IRQ} and \overline{NMI} Interrupt Timing



(NOTE) Waveform measurements for all inputs and outputs are specified at logic "High" = V_{IHmin} and logic "Low" = V_{ILmax} unless otherwise specified.
E clock shown for reference only.

Figure 10 \overline{FIRQ} Interrupt Timing

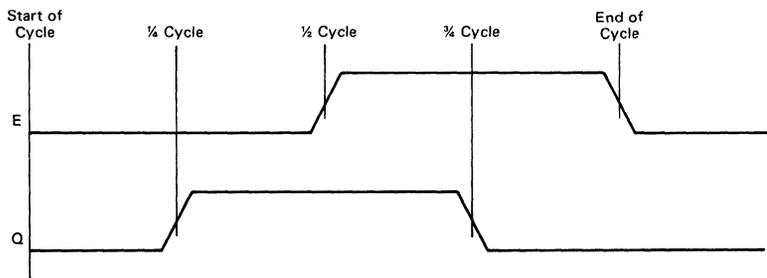
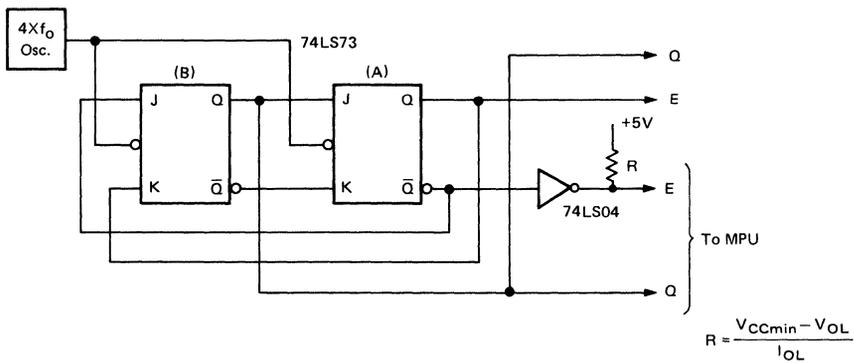
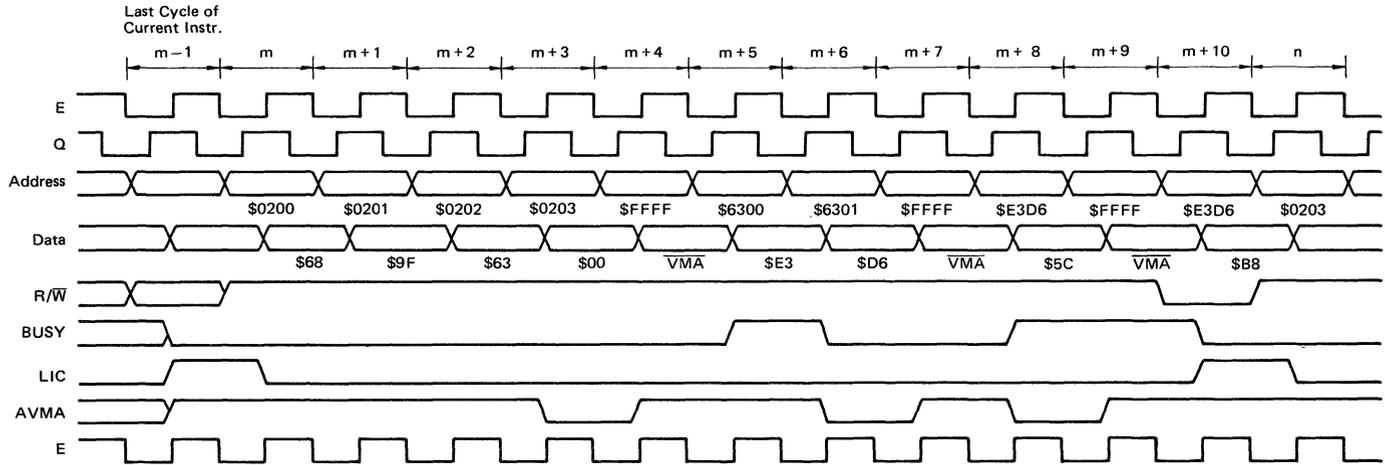


Figure 11 HD6809E Clock Generator

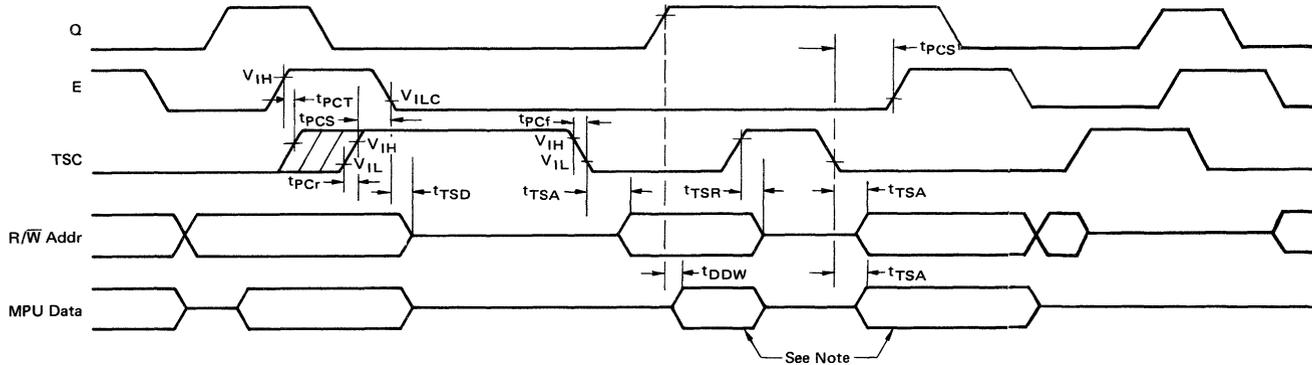
Memory Location	Memory Contents	Contents Description
PC → \$0200	\$68	ASL Indexed Opcode
\$0201	\$9F	Extended Indirect Postbyte
\$0202	\$63	Indirect Address Hi-Byte
\$0203	\$00	Indirect Address Lo-Byte
\$0204		Next Main Instruction
\$6300	\$E3	Effective Address Hi-Byte
\$6301	\$D6	Effective Address Lo-Byte
\$E3D6	\$5C	Target Data

Figure 12 Read Modify Write Instruction Example (ASL Extended Indirect)



(NOTE) Waveform measurements for all inputs and outputs are specified at logic "High" = V_{IHmin} and logic "Low" = V_{ILmax} unless otherwise specified.

Figure 13 BUSY Timing (ASL Extended Indirect Instruction)



(NOTES) Data will be asserted by the MPU only during the interval while R/\bar{W} is "Low" and E or Q is "High".
Waveform measurements for all inputs and outputs are specified at logic "High" = V_{IHmin} and logic "Low" = V_{ILmax} unless otherwise specified.

Figure 14 TSC Timing

■ ADDRESSING MODES

The basic instructions of any computer are greatly enhanced by the presence of powerful addressing modes. The HD6809E has the most complete set of addressing modes available on any microcomputer today. For example, the HD6809E has 59 basic instructions; however, it recognizes 1464 different variations of instructions and addressing modes. The addressing modes support modern programming techniques. The following addressing modes are available on the HD6809E:

- (1) Implied (Includes Accumulator)
- (2) Immediate
- (3) Extended
- (4) Extended Indirect
- (5) Direct
- (6) Register
- (7) Indexed
 - Zero-Offset
 - Constant Offset
 - Accumulator Offset
 - Auto Increment/Decrement
- (8) Indexed Indirect
- (9) Relative
- (10) Program Counter Relative

● Implied (Includes Accumulator)

In this addressing mode, the opcode of the instruction contains all the address information necessary. Examples of Implied Addressing are: ABX, DAA, SWI, ASRA, and CLR.B.

● Immediate Addressing

In Immediate Addressing, the effective address of the data is the location immediately following the opcode (i.e., the data to be used in the instruction immediately follows the opcode of the instruction). The HD6809E uses both 8 and 16-bit immediate values depending on the size of argument specified by the opcode. Examples of instructions with immediate Addressing are:

```
LDA #S20
LDX #SF000
LDY #CAT
```

(NOTE) # signifies immediate addressing, \$ signifies hexadecimal value.

● Extended Addressing

In Extended Addressing, the contents of the two bytes immediately following the opcode fully specify the 16-bit effective address used by the instruction. Note that the address generated by an extended instruction defines an absolute address and is not position independent. Examples of Extended Addressing include:

```
LDA CAT
STX MOUSE
LDD $2000
```

● Extended Indirect

As a special case of indexed addressing (discussed below), one level of indirection may be added to Extended Addressing. In Extended Indirect, the two bytes following the postbyte of an Indexed instruction contain the address of the data.

```
LDA [CAT]
LDX [SFFF]
STU [DOG]
```

● Direct Addressing

Direct addressing is similar to extended addressing except that only one byte of address follows the opcode. This byte specifies the lower 8 bits of the address to be used. The upper 8 bits of the address are supplied by the direct page register. Since only one byte of address is required in direct addressing, this mode requires less memory and executes faster than extended addressing. Of course, only 256 locations (one page) can be accessed without redefining the contents of the DP register. Since the DP register is set to \$00 on Reset, direct addressing on the HD6809E is compatible with direct addressing on the HD6800. Indirection is not allowed in direct addressing. Some examples of direct addressing are:

```
LDA $30
SETDP $10 (Assembler directive)
LDB $1030
LDD <CAT
```

(NOTE) < is an assembler directive which forces direct addressing.

● Register Addressing

Some opcodes are followed by a byte that defines a register or set of registers to be used by the instruction. This is called a postbyte. Some examples of register addressing are:

```
TFR X, Y Transfer X into Y
EXG A, B Exchanges A with B
PSHS A, B, X, Y Push Y, X, B and A onto S
PULU X, Y, D Pull D, X, and Y from U
```

● Indexed Addressing

In all indexed addressing, one of the pointer registers (X, Y, U, S, and sometimes PC) is used in a calculation of the effective address of the operand to be used by the instruction. Five basic types of indexing are available and are discussed below. The postbyte of an indexed instruction specifies the basic type and variation of the addressing mode as well as the pointer register to be used. Figure 16 lists the legal formats for the postbyte. Table 2 gives the assembler form and the number of cycles and bytes added to the basic values for indexed addressing for each variation.

Post-Byte Register Bit								Indexed Addressing Mode
7	6	5	4	3	2	1	0	
0	R	R	d	d	d	d	d	EA = ,R + 5 Bit Offset
1	R	R	0	0	0	0	0	,R +
1	R	R	i	0	0	0	1	,R ++
1	R	R	0	0	0	1	0	,-R
1	R	R	i	0	0	1	1	,--R
1	R	R	i	0	1	0	0	EA = ,R + 0 Offset
1	R	R	i	0	1	0	1	EA = ,R + ACCB Offset
1	R	R	i	0	1	1	0	EA = ,R + ACCA Offset
1	R	R	i	1	0	0	0	EA = ,R + 8 Bit Offset
1	R	R	i	1	0	0	1	EA = ,R + 16 Bit Offset
1	R	R	i	1	0	1	1	EA = ,R + D Offset
1	x	x	1	1	1	0	0	EA = ,PC + 8 Bit Offset
1	x	x	1	1	1	0	1	EA = ,PC + 16 Bit Offset
1	R	R	i	1	1	1	1	EA = [,Address]

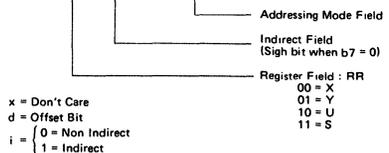


Figure 16 Index Addressing Postbyte Register Bit Assignments

Table 2 Indexed Addressing Mode

Type	Forms	Non Indirect			Indirect		
		Assembler Form	Postbyte OP Code	+ ~ #	Assembler Form	Postbyte OP Code	+ ~ #
Constant Offset From R (2's Complement Offsets)	No Offset	,R	1RR00100	0 0	[,R]	1RR10100	3 0
	5 Bit Offset	n, R	0RRnnnnn	1 0	defaults to 8-bit		
	8 Bit Offset	n, R	1RR01000	1 1	[n, R]	1RR11000	4 1
	16 Bit Offset	n, R	1RR01001	4 2	[n, R]	1RR11001	7 2
Accumulator Offset From R (2's Complement Offsets)	A Register Offset	A, R	1RR00110	1 0	[A, R]	1RR10110	4 0
	B Register Offset	B, R	1RR00101	1 0	[B, R]	1RR10101	4 0
	D Register Offset	D, R	1RR01011	4 0	[D, R]	1RR11011	7 0
Auto Increment/Decrement R	Increment By 1	,R +	1RR00000	2 0	not allowed		
	Increment By 2	,R ++	1RR00001	3 0	[,R ++]	1RR10001	6 0
	Decrement By 1	, - R	1RR00010	2 0	not allowed		
	Decrement By 2	, -- R	1RR00011	3 0	[, -- R]	1RR10011	6 0
Constant Offset From PC (2's Complement Offsets)	8 Bit Offset	n, PCR	1xx01100	1 1	[n, PCR]	1xx11100	4 1
	16 Bit Offset	n, PCR	1xx01101	5 2	[n, PCR]	1xx11101	8 2
Extended Indirect	16 Bit Address	-	-	- -	[n]	10011111	5 2

R = X, Y, U or S RR:
 x = Don't Care 00 = X
 01 = Y
 10 = U
 11 = S

+ and # indicate the number of additional cycles and bytes for the particular variation.

Zero-Offset Indexed

In this mode, the selected pointer register contains the effective address of the data to be used by the instruction. This is the fastest indexing mode.

Examples are:
 LDD 0, X
 LDA S

Constant Offset Indexed

In this mode, a two's-complement offset and the contents of one of the pointer registers are added to form the effective address of the operand. The pointer register's initial content is unchanged by the addition.

Three sizes of offsets are available:
 5-bit (-16 to +15)
 8-bit (-128 to +127)
 16-bit (-32768 to +32767)

The two's complement 5-bit offset is included in the postbyte and, therefore, is most efficient in use of bytes and cycles. The two's complement 8-bit offset is contained in a single byte following the postbyte. The two's complement 16-bit offset is in the two bytes following the postbyte. In most cases the programmer need not be concerned with the size of this offset since the assembler will select the optimal size automatically.

Examples of constant-offset indexing are:
 LDA 23, X
 LDX -2, S

LDY 300, X
 LDU CAT, Y

Accumulator-Offset Indexed

This mode is similar to constant offset indexed except that the two's-complement value in one of the accumulators (A, B or D) and the contents of one of the pointer registers are added to form the effective address of the operand. The contents of both the accumulator and the pointer register are unchanged by the addition. The postbyte specifies which accumulator to use as an offset and no additional bytes are required. The advantage of an accumulator offset is that the value of the offset can be calculated by a program at run-time.

Some examples are:
 LDA B, Y
 LDX D, Y
 LEAX B, X

Auto Increment/Decrement Indexed

In the auto increment addressing mode, the pointer register contains the address of the operand. Then, after the pointer register is used it is incremented by one or two. This addressing mode is useful in stepping through tables, moving data, or for the creation of software stacks. In auto decrement, the pointer register is decremented prior to use as the address of the data. The use of auto decrement is similar to that of auto increment; but the tables, etc., are scanned from the high to low addresses. The size of the increment/decrement can be either one or two to allow for tables of either 8- or 16-bit data to be accessed and is selectable by the programmer. The pre-

decrement, post-increment nature of these modes allow them to be used to create additional software stacks that behave identically to the U and S stacks.

Some examples of the auto increment/decrement addressing modes are:

```
LDA  ,X +
STD  ,Y ++
LDB  ,-Y
LDX  ,--S
```

Care should be taken in performing operations on 16-bit pointer registers (X, Y, U, S) where the same register is used to calculate the effective address.

Consider the following instruction:

```
STX 0, X++ (X initialized to 0)
```

The desired result is to store a 0 in locations \$0000 and \$0001 then increment X to point to \$0002. In reality, the following occurs:

```
0 → temp    calculate the EA; temp is a holding register
X + 2 → X    perform autoincrement
X → (temp)  do store operation
```

• Indexed Indirect

All of the indexing modes with the exception of auto increment/decrement by one, or a ±4-bit offset may have an additional level of indirection specified. In indirect addressing, the effective address is contained at the location specified by the contents of the Index Register plus any offset. In the example below, the A accumulator is loaded indirectly using an effective address calculated from the Index Register and an offset.

```
Before Execution
A = XX (don't care)
X = $F000
$0100 LDA [$10, X]    EA is now $F010
$F010 $F1             $F150 is now the
$F011 $50             new EA
$F150 $AA
After Execution
A = $AA (Actual Data Loaded)
X = $F000
```

All modes of indexed indirect are included except those which are meaningless (e.g., auto increment/decrement by 1 indirect). Some examples of indexed indirect are:

```
LDA  [, X]
LDD  [10, S]
LDA  [B, Y]
LDD  [, X++]
```

• Relative Addressing

The byte(s) following the branch opcode is (are) treated as a signed offset which may be added to the program counter. If the branch condition is true then the calculated address (PC + signed offset) is loaded into the program counter. Program execution continues at the new location as indicated by the PC; short (1 byte offset) and long (2 bytes offset) relative addressing modes are available. All of memory can be reached in long relative addressing as an effective address is interpreted modulo 2¹⁶. Some examples of relative addressing are:

```
BEQ  CAT    (short)
BGT  DOG    (short)
```

```
CAT  LBEQ   RAT    (long)
DOG  LBGT   RABBIT (long)
.
.
.
RAT  NOP
RABBIT NOP
```

• Program Counter Relative

The PC can be used as the pointer register with 8 or 16-bit signed offsets. As in relative addressing, the offset is added to the current PC to create the effective address. The effective address is then used as the address of the operand or data. Program Counter Relative Addressing is used for writing position independent programs. Tables related to a particular routine will maintain the same relationship after the routine is moved, if referenced relative to the Program Counter. Examples are:

```
LDA  CAT, PCR
LEAX TABLE, PCR
```

Since program counter relative is a type of indexing, an additional level of indirection is available.

```
LDA  [CAT, PCR]
LDU  [DOG, PCR]
```

■ HD6809E INSTRUCTION SET

The instruction set of the HD6809E is similar to that of the HD6800 and is upward compatible at the source code level. The number of opcodes has been reduced from 72 to 59, but because of the expanded architecture and additional addressing modes, the number of available opcodes (with different addressing modes) has risen from 197 to 1464.

Some of the new instructions are described in detail below:

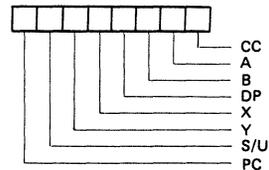
• PSHU/PSHS

The push instructions have the capability of pushing onto either the hardware stack (S) or user stack (U) any single register, or set of registers with a single instruction.

• PULU/PULS

The pull instructions have the same capability of the push instruction, in reverse order. The byte immediately following the push or pull opcode determines which register or registers are to be pushed or pulled. The actual PUSH/PULL sequence is fixed; each bit defines a unique register to push or pull, as shown in below.

PUSH/PULL POST BYTE



```
← Pull Order          Push Order →
PC  U  Y  X  DP  B  A  CC
FFFF ..... ← increasing memory address ..... 0000
PC  S  Y  X  DP  B  A  CC
```

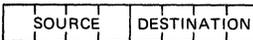
• **TFR/EXG**

Within the HD6809E, any register may be transferred to or exchanged with another of like-size; i.e., 8-bit to 8-bit or 16-bit to 16-bit. Bits 4~7 of postbyte define the source register, while bits 0~3 represent the destination register. These are denoted as follows:

0000 - D	0101 - PC
0001 - X	1000 - A
0010 - Y	1001 - B
0011 - U	1010 - CC
0100 - S	1011 - DP

(NOTE) All other combinations are undefined and INVALID.

TRANSFER/EXCHANGE POST BYTE



• **LEAX/LEAY/LEAU/LEAS**

The LEA (Load Effective Address) works by calculating the effective address used in an indexed instruction and stores that address value, rather than the data at that address, in a pointer register. This makes all the features of the internal addressing hardware available to the programmer. Some of the implications of this instruction are illustrated in Table 3.

The LEA instruction also allows the user to access data in a position independent manner. For example:

```

LEAX   MSG1, PCR
LBSR   PDATA (Print message routine)
.
MSG1   FCC    'MESSAGE'
```

This sample program prints: 'MESSAGE'. By writing MSG1, PCR, the assembler computes the distance between the present address and MSG1. This result is placed as a constant into the LEAX instruction which will be indexed from the PC value at the time of execution. No matter where the code is located, when it is executed, the computed offset from the PC will put the absolute address of MSG1 into the X pointer register. This code is totally position independent.

The LEA instructions are very powerful and use an internal holding register (temp). Care must be exercised when using the LEA instructions with the autoincrement and autodecrement addressing modes due to the sequence of internal operations. The LEA internal sequence is outlined as follows:

- LEAa, b+ (any of the 16-bit pointer registers X, Y, U or S may be substituted for a and b.)
 1. b → temp (calculate the EA)
 2. b + 1 → b (modify b, postincrement)
 3. temp → a (load a)
- LEAa, - b
 1. b - 1 → temp (calculate EA with predecrement)
 2. b - 1 → b (modify b, predecrement)
 3. temp → a (load a)

Autoincrement-by-two and autodecrement-by-two instructions work similarly. Note that LEAX, X+ does not change X, however LEAX, -X does decrement X. LEAX 1, X should be used to increment X by one.

Table 3 LEA Examples

Instruction	Operation	Comment
LEAX 10, X	X + 10 → X	Adds 5-bit constant 10 to X
LEAX 500, X	X + 500 → X	Adds 16-bit constant 500 to X
LEAY A, Y	Y + A → Y	Adds 8-bit A accumulator to Y
LEAY D, Y	Y + D → Y	Adds 16-bit D accumulator to Y
LEAU -10, U	U - 10 → U	Subtracts 10 from U
LEAS -10, S	S - 10 → S	Used to reserve area on stack
LEAS 10, S	S + 10 → S	Used to 'clean up' stack
LEAX 5, S	S + 5 → X	Transfers as well as adds

• **MUL**

Multiplies the unsigned binary numbers in the A and B accumulator and places the unsigned result into the 16-bit D accumulator. This unsigned multiply also allows multiple-precision multiplications.

Long and Short Relative Branches

The HD6809E has the capability of program counter relative branching throughout the entire memory map. In this mode, if the branch is to be taken, the 8 or 16-bit signed offset is added to the value of the program counter to be used as the effective address. This allows the program to branch anywhere in the 64k memory map. Position independent code can be easily generated through the use of relative branching. Both short (8-bit) and long (16-bit) branches are available.

• **SYNC**

After encountering a Sync instruction, the MPU enters a Sync state, stops processing instructions and waits for an interrupt. If the pending interrupt is non-maskable (NMI) or maskable (FIRQ, IRQ) with its mask bit (F or I) clear, the processor will clear the Sync state and perform the normal interrupt stacking and service routine. Since FIRQ and IRQ are not edge-triggered, a low level with a minimum duration of three bus cycles is required to assure that the interrupt will be taken. If the pending interrupt is maskable (FIRQ, IRQ) with its mask bit (F or I) set, the processor will clear the Sync state and continue processing by executing the next inline instruction. Figure 17 depicts Sync timing.

Software Interrupts

A Software Interrupt is an instruction which will cause an interrupt, and its associated vector fetch. These Software Interrupts are useful in operating system calls, software debugging, trace operations, memory mapping, and software development systems. Three levels of SWI are available on this HD6809E, and are prioritized in the following order: SWI, SWI2, SWI3.

16-Bit Operation

The HD6809E has the capability of processing 16-bit data. These instructions include loads, stores, compares, adds, subtracts, transfers, exchanges, pushes and pulls.

■ **CYCLE-BY-CYCLE OPERATION**

The address bus cycle-by-cycle performance chart illustrates the memory-access sequence corresponding to each possible instruction and addressing mode in the HD6809E. Each instruction begins with an opcode fetch. While that opcode is being internally decoded, the next program byte is always fetched. (Most instructions will use the next byte, so this

technique considerably speeds throughput.) Next, the operation of each opcode will follow the flow chart. \overline{VMA} is an indication of $FFFF_{16}$ on the address bus, R/\overline{W} = "High" and BS = "Low". The following examples illustrate the use of the chart; see Figure 18.

Example 1: LBSR (Branch Taken)
Before Execution $SP = F000$

	.		
	.		
	.		
\$8000	LBSR	CAT	
	.		
	.		
\$A000	CAT		

CYCLE-BY-CYCLE FLOW

Cycle #	Address	Data	R/ \overline{W}	Description
1	8000	17	1	Opcode Fetch
2	8001	1F	1	Offset High Byte
3	8002	FD	1	Offset Low Byte
4	FFFF	*	1	\overline{VMA} Cycle
5	FFFF	*	1	\overline{VMA} Cycle
6	FFFF	*	1	\overline{VMA} Cycle
7	FFFF	*	1	\overline{VMA} Cycle
8	EFFE	03	0	Stack Low Order Byte of Return Address
9	EFEE	80	0	Stack High Order Byte of Return Address

Example 2: DEC (Extended)

\$8000	DEC	\$A000
\$A000	FCB	\$80

Cycle #	Address	Data	R/ \overline{W}	Description
1	8000	7A	1	Opcode Fetch
2	8001	A0	1	Operand Address, High Byte
3	8002	00	1	Operand Address, Low Byte
4	FFFF	*	1	\overline{VMA} Cycle
5	A000	80	1	Read the Data
6	FFFF	*	1	\overline{VMA} Cycle
7	A000	7F	0	Store the Decremented Data

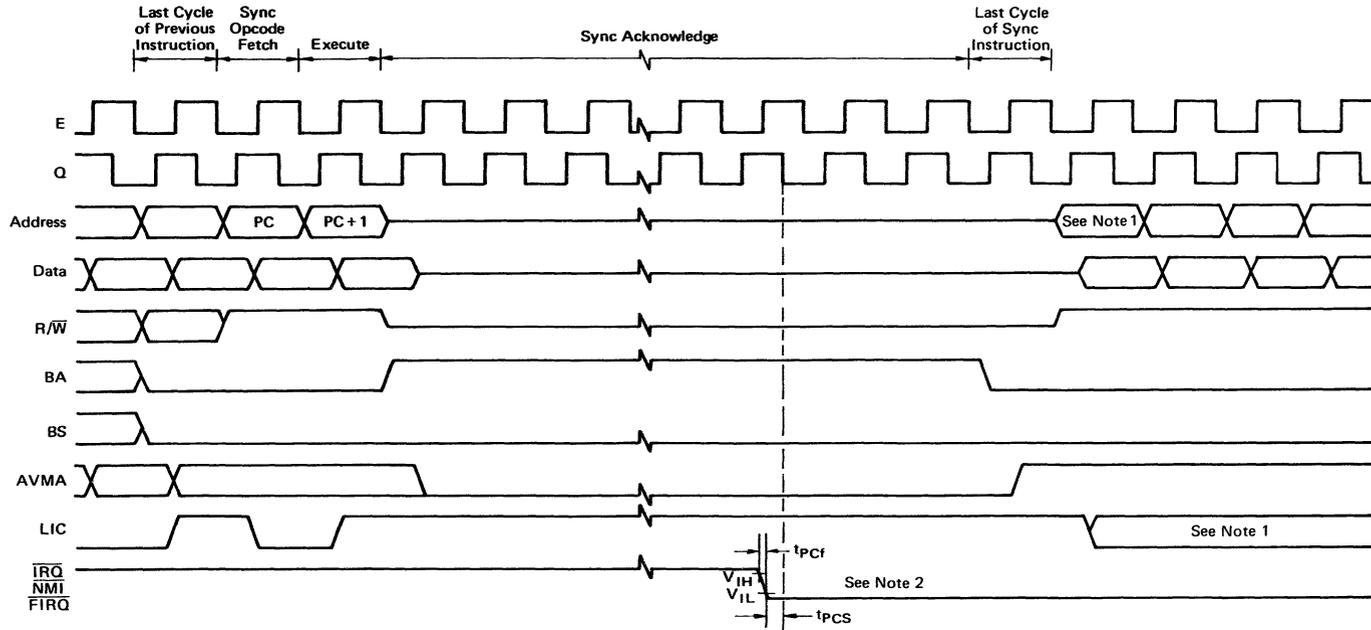
* The data bus has the data at that particular address.

■ HD6809E INSTRUCTION SET TABLES

The instructions of the HD6809E have been broken down into five different categories. They are as follows:

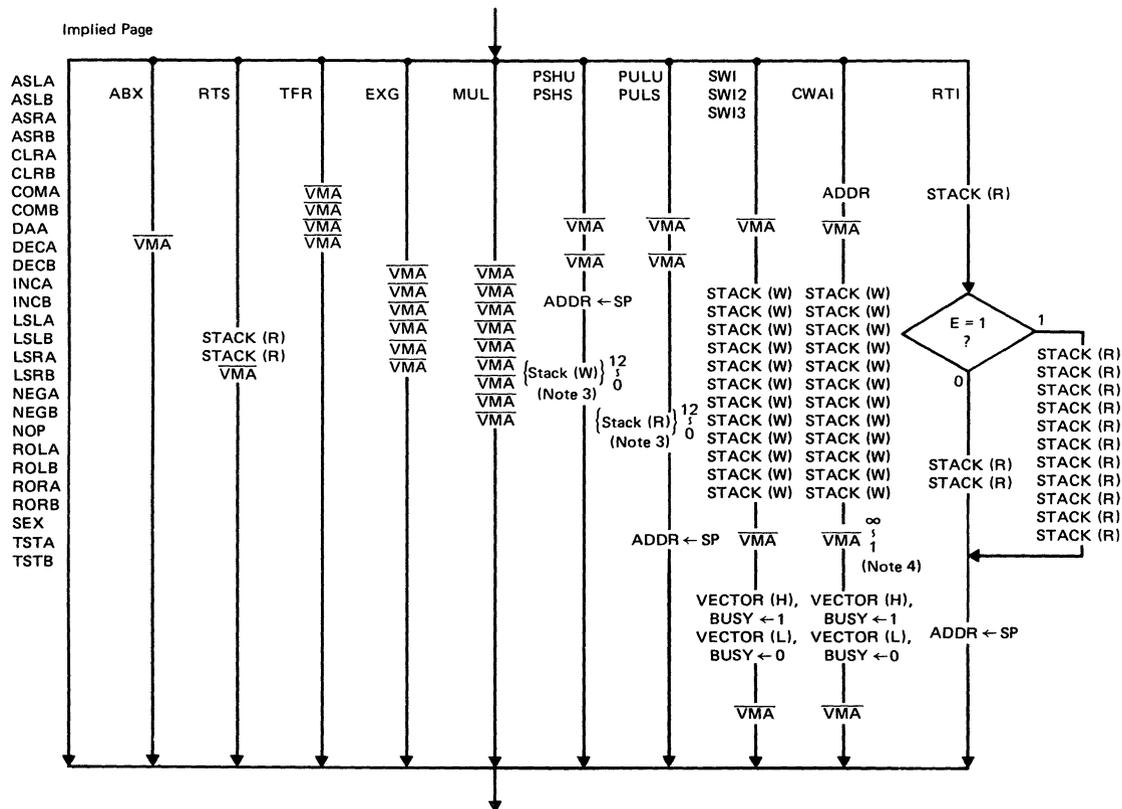
- 8-Bit operation (Table 4)
- 16-Bit operation (Table 5)
- Index register/stack pointer instructions (Table 6)
- Relative branches (long or short) (Table 7)
- Miscellaneous instructions (Table 8)

HD6809E instruction set tables and Hexadecimal Values of instructions are shown in Table 9 and Table 10.



- (NOTES) 1. If the associated mask bit is set when the interrupt is requested, LIC will go "Low" and this cycle will be an instruction fetch from address location PC + 1. However, if the interrupt is accepted (NMI or an unmasked FIRQ or IRQ) LIC will remain "High" and interrupt processing will start with this cycle as (m) on Figure 9 and 10 (Interrupt Timing).
2. If mask bits are clear, IRQ and FIRQ must be held "Low" for three cycles to guarantee that interrupt will be taken, although only one cycle is necessary to bring the processor out of SYNC.
3. Waveform measurements for all inputs and outputs are specified at logic "High" = V_{IHmin} and logic "Low" = V_{ILmax} unless otherwise specified.

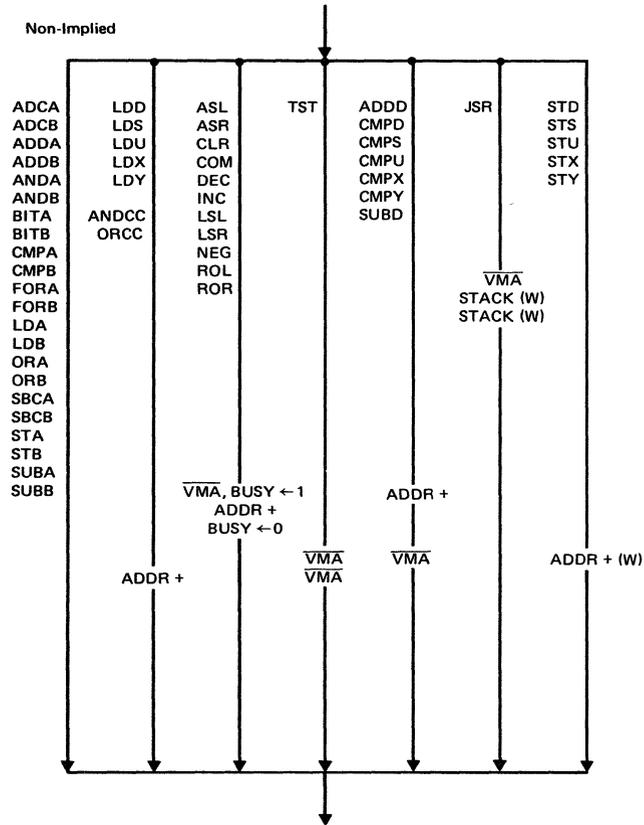
Figure 17 SYNC Timing



(NOTES)

- Stack (W) refers to the following sequence: $SP \leftarrow SP - 1$, then $ADDR \leftarrow SP$ with $R/\overline{W} = \text{"Low"}$
Stack (R) refers to the following sequence: $ADDR \leftarrow SP$ with $R/\overline{W} = \text{"High"}$, then $SP \leftarrow SP + 1$.
PSHU, PULU instructions use the user stack pointer (i.e., $SP = U$) and PSHS, PULS use the hardware stack pointer (i.e., $SP = S$).
- Vector refers to the address of an interrupt or reset vector (see Table 1).
- The number of stack accesses will vary according to the number of bytes saved.
- VMA cycles will occur until an interrupt occurs.

Figure 18 Address Bus Cycle-by-Cycle Performance (Continued)



(NOTES)

- Stack (W) refers to the following sequence: $\text{SP} \leftarrow \text{SP} - 1$, then $\text{ADDR} \leftarrow \text{SP}$ with $\overline{R/\overline{W}} = \text{"Low"}$
Stack (R) refers to the following sequence: $\text{ADDR} \leftarrow \text{SP}$ with $\overline{R/\overline{W}} = \text{"High"}$, then $\text{SP} \leftarrow \text{SP} + 1$.
PSHU, PULU instructions use the user stack pointer (i.e., $\text{SP} = \text{U}$) and PSHS, PULS use the hardware stack pointer (i.e., $\text{SP} = \text{S}$).
- Vector refers to the address of an interrupt or reset vector (see Table 1).
- The number of stack accesses will vary according to the number of bytes saved.
- \overline{VMA} cycles will occur until an interrupt occurs.

Figure 18 Address Bus Cycle-by-Cycle Performance (Continued)

Table 4 8-Bit Accumulator and Memory Instructions

Mnemonic(s)	Operation
ADCA, ADCB	Add memory to accumulator with carry
ADDA, ADDB	Add memory to accumulator
ANDA, ANDB	And memory with accumulator
ASL, ASLA, ASLB	Arithmetic shift of accumulator or memory left
ASR, ASRA, ASRB	Arithmetic shift of accumulator or memory right
BITA, BITB	Bit test memory with accumulator
CLR, CLRA, CLRB	Clear accumulator or memory location
CMPA, CMPB	Compare memory from accumulator
COM, COMA, COMB	Complement accumulator or memory location
DAA	Decimal adjust A accumulator
DEC, DECA, DECB	Decrement accumulator or memory location
EORA, EORB	Exclusive or memory with accumulator
EXG R1, R2	Exchange R1 with R2 (R1, R2 = A, B, CC, DP)
INC, INCA, INCB	Increment accumulator or memory location
LDA, LDB	Load accumulator from memory
LSL, LSLA, LSLB	Logical shift left accumulator or memory location
LSR, LSRA, LSRB	Logical shift right accumulator or memory location
MUL	Unsigned multiply ($A \times B \rightarrow D$)
NEG, NEGA, NEGB	Negate accumulator or memory
ORA, ORB	Or memory with accumulator
ROL, ROLA, ROLB	Rotate accumulator or memory left
ROR, RORA, RORB	Rotate accumulator or memory right
SBCA, SBCB	Subtract memory from accumulator with borrow
STA, STB	Store accumulator to memory
SUBA, SUBB	Subtract memory from accumulator
TST, TSTA, TSTB	Test accumulator or memory location
TFR R1, R2	Transfer R1 to R2 (R1, R2 = A, B, CC, DP)

(NOTE) A, B, CC or DP may be pushed to (pulled from) either stack with PSHS, PSHU (PULS, PULU) instructions.

Table 5 16-Bit Accumulator and Memory Instructions

Mnemonic(s)	Operation
ADDD	Add memory to D accumulator
CMPD	Compare memory from D accumulator
EXG D, R	Exchange D with X, Y, S, U or PC
LDD	Load D accumulator from memory
SEX	Sign Extend B accumulator into A accumulator
STD	Store D accumulator to memory
SUBD	Subtract memory from D accumulator
TFR D, R	Transfer D to X, Y, S, U or PC
TFR R, D	Transfer X, Y, S, U or PC to D

(NOTE) D may be pushed (pulled) to either stack with PSHS, PSHU (PULS, PULU) instructions.

Table 6 Index Register Stack Pointer Instructions

Mnemonic(s)	Operation
CMPS, CMPU	Compare memory from stack pointer
CMPX, CMPY	Compare memory from index register
EXG R1, R2	Exchange D, X, Y, S, U or PC with D, X, Y, S, U or PC
LEAS, LEAU	Load effective address into stack pointer
LEAX, LEAY	Load effective address into index register
LDS, LDU	Load stack pointer from memory
LDX, LDY	Load index register from memory
PSHS	Push A, B, CC, DP, D, X, Y, U, or PC onto hardware stack
PSHU	Push A, B, CC, DP, D, X, Y, S, or PC onto user stack
PULS	Pull A, B, CC, DP, D, X, Y, U or PC from hardware stack
PULU	Pull A, B, CC, DP, D, X, Y, S or PC from user stack
STS, STU	Store stack pointer to memory
STX, STY	Store index register to memory
TFR R1, R2	Transfer D, X, Y, S, U or PC to D, X, Y, S, U or PC
ABX	Add B accumulator to X (unsigned)

Table 7 Branch Instructions

Mnemonic(s)	Operation
SIMPLE BRANCHES	
BEQ, LBEQ	Branch if equal
BNE, LBNE	Branch if not equal
BMI, LBMI	Branch if minus
BPL, LBPL	Branch if plus
BCS, LBCS	Branch if carry set
BCC, LBCC	Branch if carry clear
BVS, LBVS	Branch if overflow set
BVC, LBVC	Branch if overflow clear
SIGNED BRANCHES	
BGT, LBGT	Branch if greater (signed)
BGE, LBGE	Branch if greater than or equal (signed)
BEQ, LBEQ	Branch if equal
BLE, LBLE	Branch if less than or equal (signed)
BLT, LBLT	Branch if less than (signed)
UNSIGNED BRANCHES	
BHI, LBHI	Branch if higher (unsigned)
BHS, LBHS	Branch if higher or same (unsigned)
BEQ, LBEQ	Branch if equal
BLS, LBLS	Branch if lower or same (unsigned)
BLO, LBLO	Branch if lower (unsigned)
OTHER BRANCHES	
BSR, LBSR	Branch to subroutine
BRA, LBRA	Branch always
BRN, LBRN	Branch never

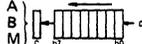
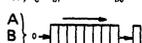
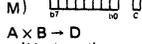
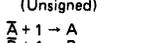
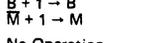
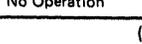
Table 8 Miscellaneous Instructions

Mnemonic(s)	Operation
ANDCC	AND condition code register
CWAI	AND condition code register, then wait for interrupt
NOP	No operation
ORCC	OR condition code register
JMP	Jump
JSR	Jump to subroutine
RTI	Return from interrupt
RTS	Return from subroutine
SWI, SWI2, SWI3	Software interrupt (absolute indirect)
SYNC	Synchronize with interrupt line

Table 9 HD6809E Instruction Set Table

INSTRUCTION/ FORMS	HD6809E ADDRESSING MODES															DESCRIPTION	5	3	2	1	0						
	IMPLIED			DIRECT			EXTENDED			IMMEDIATE			INDEXED ^①									RELATIVE					
	OP	~	#	OP	~	#	OP	~	#	OP	~	#	OP	~	#							OP	~	#	H	N	Z
ABX	3A	3	1																B + X → X (UNSIGNED) A + M + C → A B + M + C → B	•	•	•	•	•			
ADC	ADCA ADCB			99	4	2	B9	5	3	89	2	2	A9	4+	2+				↓	↓	↓	↓	↓				
ADD	ADDA ADDB ADDD			9B	4	2	BB	5	3	8B	2	2	AB	4+	2+				↓	↓	↓	↓	↓				
AND	ANDA ANDB ANDCC			DB	4	2	FB	5	3	CB	2	2	EB	4+	2+				↓	↓	↓	↓	↓				
ASL	ASLA ASLB ASL	48 58	2 2	1 1															A B M	8 8 8	↓ ↓ ↓	↓ ↓ ↓	↓ ↓ ↓	↓ ↓ ↓			
ASR	ASRA ASRB ASR	47 57	2 2	1 1	08	6	2	78	7	3			68	6+	2+				A B M	8 8 8	↓ ↓ ↓	↓ ↓ ↓	↓ ↓ ↓	↓ ↓ ↓			
BCC	BCC LBCC															24 10 24	3 5(6)	2 4				Branch C = 0 Long Branch C = 0	•	•	•	•	•
BCS	BCS LBCS															25 10 25	3 5(6)	2 4				Branch C = 1 Long Branch C = 1	•	•	•	•	•
BEQ	BEQ LBEQ															27 10 27	3 5(6)	2 4				Branch Z = 1 Long Branch Z = 1	•	•	•	•	•
BGE	BGE LBGE															2C 10 2C	3 5(6)	2 4				Branch N ⊕ V = 0 Long Branch N ⊕ V = 0	•	•	•	•	•
BGT	BGT LBGT															2E 10 2E	3 5(6)	2 4				Branch ZV(N ⊕ V) = 0 Long Branch ZV(N ⊕ V) = 0	•	•	•	•	•
BHI	BHI LBHI															22 10 22	3 5(6)	2 4				Branch CVZ = 0 Long Branch CVZ = 0	•	•	•	•	•
BHS	BHS LBHS															24 10 24	3 5(6)	2 4				Branch C = 0 Long Branch C = 0	•	•	•	•	•
BIT	BITA BITB				95	4	2	B5	5	3	85	2	2	A5	4+	2+				•	↓	↓	0	•			
BLE	BLE LBLE				D5	4	2	F5	5	3	C5	2	2	E5	4+	2+				•	↓	↓	0	•			
BLO	BLO LBLO															2F 10 2F	3 5(6)	2 4				Branch ZV(N ⊕ V) = 1 Long Branch ZV(N ⊕ V) = 1	•	•	•	•	•
BLS	BLS LBLS															25 10 25	3 5(6)	2 4				Branch C = 1 Long Branch C = 1	•	•	•	•	•
BLT	BLT LBLT															23 10 23	3 5(6)	2 4				Branch CVZ = 1 Long Branch CVZ = 1	•	•	•	•	•
BMI	BMI LBMI															2D 10 2D	3 5(6)	2 4				Branch N ⊕ V = 1 Long Branch N ⊕ V = 1	•	•	•	•	•
BNE	BNE LBNE															2B 10 2B	3 5(6)	2 4				Branch N = 1 Long Branch N = 1	•	•	•	•	•
BPL	BPL LBPL															26 10 26	3 5(6)	2 4				Branch Z = 0 Long Branch Z = 0	•	•	•	•	•
BRA	BRA LBRA															2A 10 2A	3 5(6)	2 4				Branch N = 0 Long Branch N = 0	•	•	•	•	•
BRN	BRN LBRN															20 16 20	3 5	2 3				Branch Always Long Branch/ Always	•	•	•	•	•
																21 10 21	3 5	2 4				Branch Never Long Branch Never	•	•	•	•	•

(to be continued)

INSTRUCTION/ FORMS		HD6809E ADDRESSING MODES															DESCRIPTION	5 3 2 1 0							
		IMPLIED			DIRECT			EXTENDED			IMMEDIATE			INDEXED ⁽⁸⁾				RELATIVE			H	N	Z	V	C
		OP	~	#	OP	~	#	OP	~	#	OP	~	#	OP	~	#		OP	~ ⁽⁹⁾	#					
BSR	BSR															8D	7	2	Branch to Subroutine	•	•	•	•	•	
	LBSR															17	9	3	Long Branch to Subroutine	•	•	•	•	•	
BVC	BVC															28	3	2	Branch V = 0	•	•	•	•	•	
	LBVC															10	5(6)	4	Long Branch V = 0	•	•	•	•	•	
BVS	BVS															29	3	2	Branch V = 1	•	•	•	•	•	
	LBVS															10	5(6)	4	Long Branch V = 1	•	•	•	•	•	
CLR	CLRA	4F	2	1															0 → A	•	0	1	0	0	
	CLRB	5F	2	1															0 → B	•	0	1	0	0	
	CLR				0F	6	2	7F	7	3					6F	6+	2+	0 → M	•	0	1	0	0		
CMP	CMPA				91	4	2	B1	5	3	81	2	2	A1	4+	2+		Compare M from A	•	8	1	1	1	1	
	CMPB				D1	4	2	F1	5	3	C1	2	2	E1	4+	2+		Compare M from B	•	8	1	1	1	1	
	CMPD				10	7	3	10	8	4	10	5	4	10	7+	3+		Compare M: M + 1 from D	•	•	•	•	•		
	CMPS				93	7	3	B3	8	4	83	5	4	A3	11	7+	3+		Compare M: M + 1 from S	•	•	•	•	•	
	CMPU				11	7	3	11	8	4	11	5	4	11	7+	3+		Compare M: M + 1 from U	•	•	•	•	•		
	CMPX				93	6	2	B3	7	3	83	4	3	A3	6+	2+		Compare M: M + 1 from X	•	•	•	•	•		
	CMPY				9C	10	7	10	8	4	10	5	4	10	7+	3+		Compare M: M + 1 from Y	•	•	•	•	•		
COM	COMA	43	2	1															\bar{A} → A	•	1	1	0	1	
	COMB	53	2	1															\bar{B} → B	•	1	1	0	1	
	COM				03	6	2	73	7	3					63	6+	2+	\bar{M} → M	•	1	1	0	1		
CWAI		3C	20	2															CC \wedge IMM → CC (except 1 → E)	(7)			
DAA		19	2	1															Wait for Interrupt	•	1	1	8	1	
DEC	DECA	4A	2	1															Decimal Adjust A	•	1	1	1	1	
	DECB	5A	2	1															A - 1 → A	•	1	1	1	1	
	DEC				0A	6	2	7A	7	3					6A	6+	2+	B - 1 → B	•	1	1	1	1		
EOR	EORA				98	4	2	B8	5	3	88	2	2	A8	4+	2+		M - 1 → M	•	1	1	1	1		
	EORB				D8	4	2	F8	5	3	C8	2	2	E8	4+	2+		A \oplus M → A	•	1	1	0	•		
EXG	R1, R2	1E	7	2															B \oplus M → B	•	1	1	0	•	
INC	INCA	4C	2	1															R1 → R2 ²	(10)			
	INCB	5C	2	1															A + 1 → A	•	1	1	1	•	
	INC				0C	6	2	7C	7	3					6C	6+	2+	B + 1 → B	•	1	1	1	•		
JMP					0E	3	2	7E	4	3					6E	3+	2+	M + 1 → M	•	1	1	1	•		
JSR					9D	7	2	BD	8	3					AD	7+	2+	EA ³ → PC	•	•	•	•	•		
LD	LDA				96	4	2	B6	5	3	86	2	2	A6	4+	2+		Jump to Subroutine	•	•	•	•	•		
	LDB				D6	4	2	F6	5	3	C6	2	2	E6	4+	2+		M → A	•	1	1	0	•		
	LDD				DC	5	2	FC	6	3	CC	3	3	EC	5+	2+		M → B	•	1	1	0	•		
	LDS				10	6	3	10	7	4	10	4	4	10	6+	3+		M: M + 1 → D	•	1	1	0	•		
	LDU				DE	5	2	FE	6	3	CE	3	3	EE	5+	2+		M: M + 1 → S	•	1	1	0	•		
	LDX				9E	5	2	BE	6	3	8E	3	3	AE	5+	2+		M: M + 1 → U	•	1	1	0	•		
	LDY				10	6	3	10	7	4	10	4	4	10	6+	3+		M: M + 1 → X	•	1	1	0	•		
					9E			BE			8E			AE				M: M + 1 → Y	•	1	1	0	•		
LEA	LEAS														32	4+	2+	EA ³ → S	•	•	•	•	•		
	LEAU														33	4+	2+	EA ³ → U	•	•	•	•	•		
	LEAX														30	4+	2+	EA ³ → X	•	•	•	•	•		
	LEAY														31	4+	2+	EA ³ → Y	•	•	•	•	•		
LSL	LSLA	48	2	1															A) 	•	•	•	•	•	
	LSLB	58	2	1															B) 	•	•	•	•	•	
	LSL				08	6	2	78	7	3					68	6+	2+	M) 	•	•	•	•	•		
LSR	LSRA	44	2	1															A) 	•	•	•	•	•	
	LSRB	54	2	1															B) 	•	•	•	•	•	
	LSR				04	6	2	74	7	3					64	6+	2+	M) 	•	•	•	•	•		
MUL		3D	11	1															A x B → D (Unsigned)	•	•	•	•	•	
NEG	NEGA	40	2	1															\bar{A} + 1 → A	(8)	1	1	1	1	
	NEGB	50	2	1															\bar{B} + 1 → B	(8)	1	1	1	1	
	NEG				00	6	2	70	7	3					60	6+	2+	\bar{M} + 1 → M	(8)	1	1	1	1		
NOP		12	2	1															No Operation	•	•	•	•	•	

(to be continued)

INSTRUCTION/ FORMS	HD6809E ADDRESSING MODES															DESCRIPTION	5	3	2	1	0				
	IMPLIED			DIRECT			EXTENDED			IMMEDIATE			INDEXED ^①									RELATIVE			
	OP	~	#	OP	~	#	OP	~	#	OP	~	#	OP	~	#							OP	~ ^⑤	#	
OR	ORA ORB ORCC				9A DA	4 4	2 2	BA FA	5 5	3 3	8A CA 1A	2 2 3	2 2 2	AA EA	4+ 4+	2+ 2+				A ∨ M → A B ∨ M → B CC ∨ IMM → CC	●	↑	↑	0	●
PSH	PSHS PSHU	34	5+ ^④	2															Push Registers on S Stack Push Registers on U Stack	●	●	●	●	●	
PUL	PULS PULU	35	5+ ^④	2															Pull Registers from S Stack Pull Registers from U Stack	(←)	(10)	(←)	(10)	(←)	
ROL	ROLA ROLB ROL	49 59	2 2	1 1										69	6+	2+				A B M	●	↑	↑	↑	↑
ROR	RORA RORB ROR	46 56	2 2	1 1	09	6	2	79	7	3				66	6+	2+				A B M	●	↑	↑	●	↑
RTI		38	6/15	1															Return From Interrupt	(←)	(7)	(←)	(7)	(←)	
RTS		39	5	1															Return From Subroutine	●	●	●	●	●	
SBC	SBCA SBCB				92 D2	4 4	2 2	B2 F2	5 5	3 3	82 C2	2 2	2 2	A2 E2	4+ 4+	2+ 2+				A - M - C → A B - M - C → B	(8)	↑	↑	↑	↑
SEX		1D	2	1															Sign Extend B into A	●	↑	↑	●	●	
ST	STA STB STD STS				97 D7 DD 10	4 4 5 6	2 2 2 3	B7 F7 FD 10	5 5 6 3	3 3 3 4				A7 E7 ED 10	4+ 4+ 5+ 6+	2+ 2+ 2+ 3+				A → M B → M D → M: M+1 S → M: M+1	●	↑	↑	0	●
	STU STX STY				DF 9F 10 9F	5 5 6 6	2 2 3 3	FF BF 10 BF	6 6 7 7	3 3 4 4				EF AF 10 AF	5+ 5+ 6+ 6+	2+ 2+ 3+ 3+				U → M: M+1 X → M: M+1 Y → M: M+1	●	↑	↑	0	●
SUB	SUBA SUBB SUBD				90 D0 93	4 4 6	2 2 2	B0 F0 B3	5 5 7	3 3 3	80 C0 83	2 2 4	2 2 3	A0 E0 A3	4+ 4+ 6+	2+ 2+ 2+				A - M → A B - M → B D - M: M+1 → D	(8)	↑	↑	↑	↑
SWI	SWI ^⑥ SWI2 ^⑥ SWI3 ^⑥	3F 10 3F 11 3F	19 20 20	1 2 2															Software Interrupt1 Software Interrupt2 Software Interrupt3	●	●	●	●	●	
SYNC		13	≥2	1															Synchronize to Interrupt	●	●	●	●	●	
TFR	R1, R2	1F	6	2															R1 → R2 ^②	(←)	(10)	(←)	(10)	(←)	
TST	TSTA TSTB TST	4D 5D	2 2	1 1	0D	6	2	7D	7	3				6D	6+	2+				Test A Test B Test M	●	↑	↑	0	●

(NOTES)

- ① This column gives a base cycle and byte count. To obtain total count, and the values obtained from the INDEXED ADDRESSING MODES table.
- ② R1 and R2 may be any pair of 8 bit or any pair of 16 bit registers.
The 8 bit registers are: A, B, CC, DP
The 16 bit registers are: X, Y, U, S, D, PC
- ③ EA is the effective address.
- ④ The PSH and PUL instructions require 5 cycle plus 1 cycle for each byte pushed or pulled.
- ⑤ 5(6) means: 5 cycles if branch not taken, 6 cycles if taken.
- ⑥ SWI sets 1 and F bits. SWI2 and SWI3 do not affect I and F.
- ⑦ Conditions Codes set as a direct result of the instruction.
- ⑧ Value of half-carry flag is undefined.
- ⑨ Special Case - Carry set if b7 is SET.
- ⑩ Condition Codes set as a direct result of the instruction if CC is specified, and not affected otherwise.

LEGEND:

- | | | | |
|----|------------------------------|----|---|
| OP | Operation Code (Hexadecimal) | Z | Zero (byte) |
| ~ | Number of MPU Cycles | V | Overflow, 2's complement |
| # | Number of Program Bytes | C | Carry from bit 7 |
| + | Arithmetic Plus | ↑ | Test and set if true, cleared otherwise |
| - | Arithmetic Minus | ● | Not Affected |
| x | Multiply | CC | Condition Code Register |
| M | Complement of M | : | Concatenation |
| → | Transfer Into | ∨ | Logical or |
| H | Half-carry (from bit 3) | ∧ | Logical and |
| N | Negative (sign bit) | ⊕ | Logical Exclusive or |

Table 10 Hexadecimal Values of Machine Codes

OP	Mnem	Mode	~	#	OP	Mnem	Mode	~	#	OP	Mnem	Mode	~	#	
00	NEG	Direct	6	2	30	LEAX	Indexed	4+	2+	60	NEG	Indexed	6+	2+	
01	*	↑			31	LEAY	Indexed	4+	2+	61	*	↑			
02	*				32	LEAS	Indexed	4+	2+	62	*				
03	COM		6	2	33	LEAU	Indexed	4+	2+	63	COM		6+	2+	
04	LSR	6	2	34	PSHS	Implied	5+	2	64	LSR	6+	2+			
05	*	↓			35	PULS	Implied	5+	2	65	*	↓			
06	ROR		6	2	36	PSHU	Implied	5+	2	66	ROR		6+	2+	
07	ASR		6	2	37	PULU	Implied	5+	2	67	ASR		6+	2+	
08	ASL, LSL	6	2	38	*	↑			68	ASL, LSL	6+	2+			
09	ROL	6	2	39	RTS		5	1	69	ROL	6+	2+			
0A	DEC	6	2	3A	ABX		3	1	6A	DEC	6+	2+			
0B	*	↓			3B	RTI	6, 15	1	6B	*	↓				
0C	INC		6	2	3C	CWAI	20	2	6C	INC		6+	2+		
0D	TST		6	2	3D	MUL	11	1	6D	TST		6+	2+		
0E	JMP	3	2	3E	*	↓			6E	JMP	3+	2+			
0F	CLR	Direct	6	2	3F		SWI	Implied	19	1	6F	CLR	Indexed	6+	2+
10	} See	-	-	-	40		NEGA	Implied	2	1	70	NEG	Extended	7	3
11	} Next Page	-	-	-	41	*	↑			71	*	↑			
12	NOP	Implied	2	1	42	*				72	*				
13	SYNC	Implied	2	1	43	COMA		2	1	73	COM		7	3	
14	*	↑			44	LSRA	2	1	74	LSR	7	3			
15	*				45	*			75	*					
16	LBRA		Relative	5	3	46	RORA	2	1	76	ROR	7	3		
17	LBSR	Relative	9	3	47	ASRA	2	1	77	ASR	7	3			
18	*	↓			48	ASLA, LSLA	2	1	78	ASL, LSL	7	3			
19	DAA		Implied	2	1	49	ROLA	2	1	79	ROL	7	3		
1A	ORCC		Immed	3	2	4A	DECA	2	1	7A	DEC	7	3		
1B	*	-			4B	*	↓			7B	*	↓			
1C	ANDCC	Immed	3	2	4C	INCA		2	1	7C	INC		7	3	
1D	SEX	Implied	2	1	4D	TSTA		2	1	7D	TST		7	3	
1E	EXG	↑	8	2	4E	*	↓			7E	JMP	4	3		
1F	TFR	Implied	6	2	4F	CLRA		Implied	2	1	7F	CLR	Extended	7	3
20	BRA	Relative	3	2	50	NEGB		Implied	2	1	80	SUBA	Immed	2	2
21	BRN	↑	3	2	51	*	↑			81	CMPA	2	2		
22	BHI		3	2	52	*				82	SBCA	2	2		
23	BLS		3	2	53	COMB		2	1	83	SUBD	4	3		
24	BHS, BCC	3	2	54	LSRB	2	1	84	ANDA	2	2				
25	BLO, BCS	3	2	55	*	↓			85	BITA	2	2			
26	BNE	3	2	56	RORB		2	1	86	LDA	2	2			
27	BEQ	3	2	57	ASRB		2	1	87	*	↓				
28	BVC	3	2	58	ASLB, LSLB	2	1	88	EORA	2		2			
29	BVS	3	2	59	ROLB	2	1	89	ADCA	2		2			
2A	BPL	3	2	5A	DECB	2	1	8A	ORA	2	2				
2B	BMI	3	2	5B	*	↓			8B	ADDA	2	2			
2C	BGE	3	2	5C	INCB		2	1	8C	CMPX	Immed	4	3		
2D	BLT	3	2	5D	TSTB		2	1	8D	BSR	Relative	7	2		
2E	BGT	3	2	5E	*	↓			8E	LDX	Immed	3	3		
2F	BLE	Relative	3	2	5F		CLRB	Implied	2	1	8F	*			

LEGEND:
 ~ Number of MPU cycles (less possible push pull or indexed-mode cycles)
 # Number of program bytes
 * Denotes unused opcode

(to be continued)

OP	Mnem	Mode	~	#	OP	Mnem	Mode	~	#	OP	Mnem	Mode	~	#
90	SUBA	Direct	4	2	C6	LDB	Immed	2	2	FC	LDD	Extended	6	3
91	CMPA	↑	4	2	C7	*	↑			FD	STD	↑	6	3
92	SBCA	↑	4	2	C8	EORB	↑	2	2	FE	LDU	↑	6	3
93	SUBD	↑	6	2	C9	ADCB	↑	2	2	FF	STU	Extended	6	3
94	ANDA	↑	4	2	CA	ORB	↑	2	2	2 Bytes Opcode				
95	BITA	↑	4	2	CB	ADDB	↑	2	2					
96	LDA	↑	4	2	CC	LDD	↑	3	3					
97	STA	↑	4	2	CD	*	↓							
98	EORA	↑	4	2	CE	LDU	Immed	3	3	1021	LBRN	Relative	5	4
99	ADCA	↑	4	2	CF	*	↑			1022	LBHI	↑	5(6)	4
9A	ORA	↑	4	2			↑			1023	LBLS	↑	5(6)	4
9B	ADDA	↑	4	2	D0	SUBB	Direct	4	2	1024	LBHS, LBCC	↑	5(6)	4
9C	CMPX	↑	6	2	D1	CMPB	↑	4	2	1025	LBCS, LBLO	↑	5(6)	4
9D	JSR	↑	7	2	D2	SBCB	↑	4	2	1026	LBNE	↑	5(6)	4
9E	LDX	↑	5	2	D3	ADDD	↑	6	2	1027	LBEQ	↑	5(6)	4
9F	STX	Direct	5	2	D4	ANDB	↑	4	2	1028	LBVC	↑	5(6)	4
		↓			D5	BITB	↑	4	2	1029	LBVS	↑	5(6)	4
A0	SUBA	Indexed	4+	2+	D6	LDB	↑	4	2	102A	LBPL	↑	5(6)	4
A1	CMPA	↑	4+	2+	D7	STB	↑	4	2	102B	LBMI	↑	5(6)	4
A2	SBCA	↑	4+	2+	D8	EORB	↑	4	2	102C	LBGE	↑	5(6)	4
A3	SUBD	↑	6+	2+	D9	ADCB	↑	4	2	102D	LBLT	↑	5(6)	4
A4	ANDA	↑	4+	2+	DA	ORB	↑	4	2	102E	LBGT	↑	5(6)	4
A5	LDA	↑	4+	2+	DB	ADDB	↑	4	2	102F	LBLE	Relative	5(6)	4
A6	STA	↑	4+	2+	DC	LDD	↑	5	2	103F	SWI2	Implied	20	2
A7	STA	↑	4+	2+	DD	STD	↑	5	2	1083	CMPD	Immed	5	4
A8	EORA	↑	4+	2+	DE	LDU	↑	5	2	108C	CMPY	↑	5	4
A9	ADCA	↑	4+	2+	DF	STU	Direct	5	2	108E	LDY	Immed	4	4
AA	ORA	↑	4+	2+			↑			1093	CMPD	Direct	7	3
AB	ADDA	↑	4+	2+	E0	SUBB	Indexed	4+	2+	109C	CMPY	↑	7	3
AC	CMPX	↑	6+	2+	E1	CMPB	↑	4+	2+	109E	LDY	↑	6	3
AD	JSR	↑	7+	2+	E2	SBCB	↑	4+	2+	109F	STY	Direct	6	3
AE	LDX	↑	5+	2+	E3	ADDD	↑	6+	2+	10A3	CMPD	Indexed	7+	3+
AF	STX	Indexed	5+	2+	E4	ANDB	↑	4+	2+	10AC	CMPY	↑	7+	3+
		↓			E5	BITB	↑	4+	2+	10AE	LDY	↑	6+	3+
B0	SUBA	Extended	5	3	E6	LDB	↑	4+	2+	10AF	STY	Indexed	6+	3+
B1	CMPA	↑	5	3	E7	STB	↑	4+	2+	10B3	CMPD	Extended	8	4
B2	SBCA	↑	5	3	E8	EORB	↑	4+	2+	10BC	CMPY	↑	8	4
B3	SUBD	↑	7	3	E9	ADCB	↑	4+	2+	10BE	LDY	↑	7	4
B4	ANDA	↑	5	3	EA	ORB	↑	4+	2+	10BF	STY	Extended	7	4
B5	BITA	↑	5	3	EB	ADDB	↑	4+	2+	10CE	LDS	Immed	4	4
B6	LDA	↑	5	3	EC	LDD	↑	5+	2+	10DE	LDS	Direct	6	3
B7	STA	↑	5	3	ED	STD	↑	5+	2+	10DF	STS	Direct	6	3
B8	EORA	↑	5	3	EE	LDU	↑	5+	2+	10EE	LDS	Indexed	6+	3+
B9	ADCA	↑	5	3	EF	STU	Indexed	5+	2+	10EF	STS	Indexed	6+	3+
BA	ORA	↑	5	3			↑			10FE	LDS	Extended	7	4
BB	ADDA	↑	5	3	F0	SUBB	Extended	5	3	10FF	STS	Extended	7	4
BC	CMPX	↑	7	3	F1	CMPB	↑	5	3	113F	SWI3	Implied	20	2
BD	JSR	↑	8	3	F2	SBCB	↑	5	3	1183	CMPU	Immed	5	4
BE	LDX	↑	6	3	F3	ADDD	↑	7	3	118C	CMPB	Immed	5	4
BF	STX	Extended	6	3	F4	ANDB	↑	5	3	1193	CMPU	Direct	7	3
		↓			F5	BITB	↑	5	3	119C	CMPB	Direct	7	3
C0	SUBB	Immed	2	2	F6	LDB	↑	5	3	11A3	CMPU	Indexed	7+	3+
C1	CMPB	↑	2	2	F7	STB	↑	5	3	11AC	CMPB	Indexed	7+	3+
C2	SBCB	↑	2	2	F8	EORB	↑	5	3	11B3	CMPU	Extended	8	4
C3	ADDD	↑	4	3	F9	ADCB	↑	5	3	11BC	CMPB	Extended	8	4
C4	ANDB	↑	2	2	FA	ORB	↑	5	3					
C5	BITB	Immed	2	2	FB	ADDB	Extended	5	3					

(NOTE): All unused opcodes are both undefined and illegal

■ NOTE FOR USE

Execution Sequence of CLR Instruction

Cycle-by-cycle flow of CLR instruction (Direct, Extended, Indexed Addressing Mode) is shown below. In this sequence the content of the memory location specified by the operand is read before writing "00" into it. Note that status Flags, such as IRQ Flag, will be cleared by this extra data read operation when accessing the control/status register (sharing the same address between read and write) of peripheral devices.

Example: CLR (Extended)

\$8000	CLR	\$A000		
\$A000	FCB	\$80		
Cycle #	Address	Data	R/ \bar{W}	Description
1	8000	7F	1	Opcode Fetch
2	8001	A0	1	Operand Address, High Byte
3	8002	00	1	Operand Address, Low Byte
4	FFFF	*	1	\bar{VMA} Cycle
5	A000	80	1	Read the Data
6	FFFF	*	1	\bar{VMA} Cycle
7	A000	00	0	Store Fixed "00" into Specified Location

* The data bus has the data at that particular address.

HD6309E

CMOS MPU (Micro Processing Unit)

The HD6309E is the highest 8-bit microprocessor of HMCS6800 family, which is just compatible with the conventional HD6809E.

The HD6309E has hardware and software features which make it an ideal processor for higher level language execution or standard controller applications. External clock inputs are provided to allow synchronization with peripherals, systems or other MPUs.

The HD6309E is complete CMOS device and the power dissipation is extremely low. Moreover the SYNC and CWAI instruction makes lower power application possible.

■ FEATURES

- Hardware – Interfaces with All HMCS6800 Peripherals
- Software – Fully Compatible with HD6809E, HD6809, HD6309 MPU families
- Low Power Consumption Mode; SYNC and CWAI instruction
- External Clock Inputs, E and Q, Allow Synchronization with other devices
- Wide Operation Range
 $f = 0.5 \text{ to } 3 \text{ MHz (} V_{CC} = 5V \pm 10\% \text{)}$

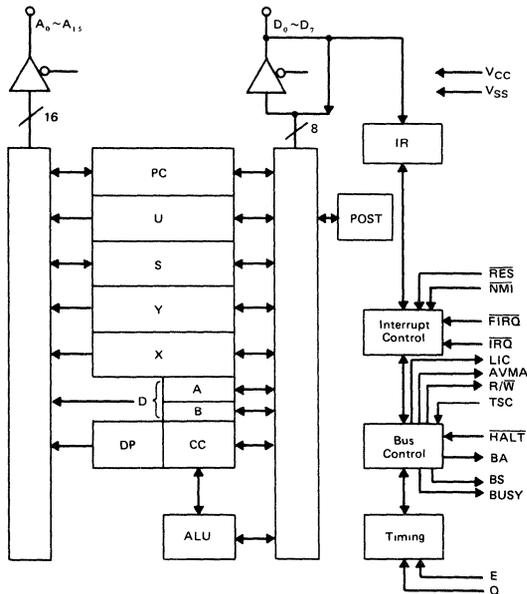
Bus Timing

2.0 MHz

2.5 MHz

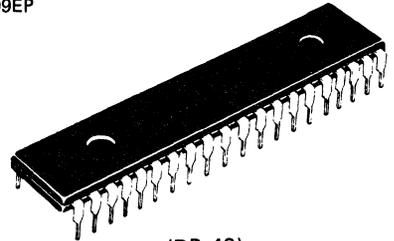
3.0 MHz

■ BLOCK DIAGRAM



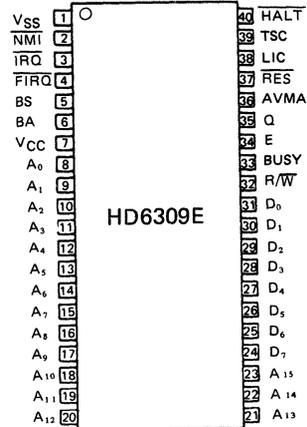
–ADVANCE INFORMATION–

HD6309EP



(DP-40)

■ PIN ARRANGEMENT



(Top View)

HD6821, HD68A21, HD68B21

PIA (Peripheral Interface Adapter)

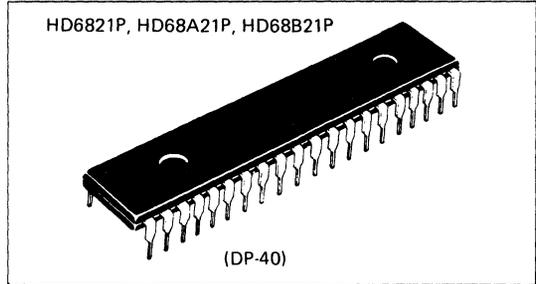
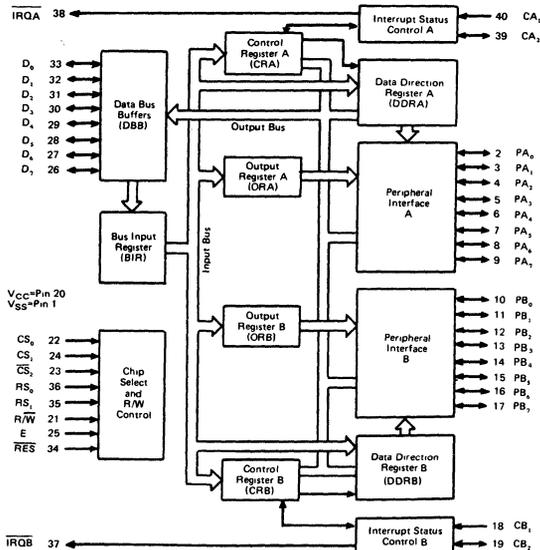
The HD6821 Peripheral Interface Adapter provides the universal means of interfacing peripheral equipment to the HD6800 Microprocessing Unit (MPU). This device is capable of interfacing the MPU to peripherals through two 8-bit bi-directional peripheral data buses and four control lines. No external logic is required for interfacing to most peripheral devices.

The functional configuration of the PIA is programmed by the MPU during system initialization. Each of the peripheral data lines can be programmed to act as an input or output, and each of the four control/interrupt lines may be programmed for one of several control modes. This allows a high degree of flexibility in the over-all operation of the interface.

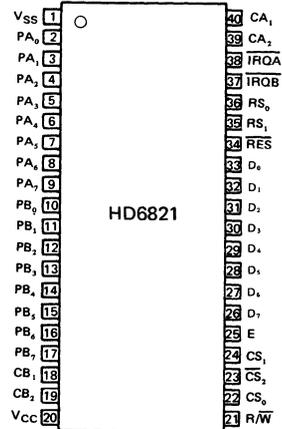
■ FEATURES

- Two Bi-directional 8-Bit Peripheral Data Bus for interface to Peripheral devices
- Two Programmable Control Registers
- Two Programmable Data Direction Registers
- Four Individually-Controlled Interrupt Input Lines: Two Usable as Peripheral Control Outputs
- Handshake Control Logic for Input and Output Peripheral Operation
- High-Impedance 3-State and Direct Transistor Drive Peripheral Lines
- Program Controlled Interrupt and Interrupt Disable Capability
- CMOS Drive Capability on Side A Peripheral Lines
- Two TTL Drive Capability on All A and B Side Buffers
- N Channel Silicon Gate MOS
- Compatible with MC6821, MC68A21 and MC68B21

■ BLOCK DIAGRAM



■ PIN ARRANGEMENT



(Top View)

■ ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Value	Unit
Supply Voltage	V_{CC}^*	-0.3 ~ +7.0	V
Input Voltage	V_{in}^*	-0.3 ~ +7.0	V
Operating Temperature	T_{opr}	-20 ~ +75	°C
Storage Temperature	T_{stg}	-55 ~ +150	°C

* With respect to V_{SS} (SYSTEM GND)

(NOTE) Permanent LSI damage may occur if maximum ratings are exceeded. Normal operation should be under recommended operating conditions. If these conditions are exceeded, it could affect reliability of LSI.

■ RECOMMENDED OPERATING CONDITIONS

Item	Symbol	min	typ	max	Unit
Supply Voltage	V_{CC}^*	4.75	5.0	5.25	V
Input Voltage	V_{IL}^*	-0.3	-	0.8	V
	V_{IH}^*	2.0	-	V_{CC}	
Operating Temperature	T_{opr}	-20	25	75	°C

* With respect to V_{SS} (SYSTEM GND)

■ ELECTRICAL CHARACTERISTICS

● DC CHARACTERISTICS ($V_{CC}=5.0V\pm 5\%$, $V_{SS}=0V$, $T_a=-20\sim+75^\circ C$, unless otherwise noted.)

Item	Symbol	Test Condition	min	typ*	max	Unit	
Input "High" Voltage	All Inputs	V_{IH}	2.0	-	V_{CC}	V	
Input "Low" Voltage	All Inputs	V_{IL}	-0.3	-	0.8	V	
Input Leakage Current	R/W, RES, RS ₀ , RS ₁ , CS ₀ , CS ₁ , CS ₂ , CA ₁ , CB ₁ , E	I_{in}	$V_{in} = 0\sim 5.25V$	-2.5	-	2.5	μA
Three-State (Off State) Input Current	D ₀ ~D ₇ , PB ₀ ~PB ₇ , CB ₂	I_{TSI}	$V_{in} = 0.4\sim 2.4V$	-10	-	10	μA
Input "High" Current	PA ₀ ~PA ₇ , CA ₂	I_{IH}	$V_{IH} = 2.4V$	-200	-	-	μA
Input "Low" Current	PA ₀ ~PA ₇ , CA ₂	I_{IL}	$V_{IL} = 0.4V$	-	-	-2.4	mA
Output "High" Voltage	D ₀ ~D ₇	V_{OH}	$I_{OH} = -205\mu A$	2.4	-	-	V
	PA ₀ ~PA ₇ , CA ₂		$I_{OH} = -200\mu A$	2.4**	-	-	
	PB ₀ ~PB ₇ , CB ₂		$I_{OH} = -10\mu A$	$V_{CC}-1.0$	-	-	
Output "Low" Voltage	D ₀ ~D ₇ , \overline{IRQA} , \overline{IROB}	V_{OL}	$I_{OL} = 1.6mA$	-	-	0.4	V
	Other Outputs		$I_{OL} = 1.6mA$	-	-	0.4	
			$I_{OL} = 3.2mA$	-	-	0.6	
Output "High" Current	D ₀ ~D ₇	I_{OH}	$V_{OH} = 2.4V$	-205	-	-	μA
	PA ₀ ~PA ₇ , CA ₂		$V_{OH} = 2.4V^{**}$	-200	-	-	μA
	PB ₀ ~PB ₇ , CB ₂		$V_{OH} = 1.5V$	-1.0	-	-10	mA
Output Leakage Current (Off State)	\overline{IRQA} , \overline{IROB}	I_{LOH}	$V_{OH} = 2.4V$	-	-	10	μA
Power Dissipation		P_D		-	260	550	mW
Input Capacitance	PA ₀ ~PA ₇ , PB ₀ ~PB ₇ , CA ₂ , CB ₂ , D ₀ ~D ₇	C_{in}	$V_{in} = 0V$, $T_a = 25^\circ C$, $f = 1.0MHz$	-	-	12.5	pF
	R/W, RES, RS ₀ , RS ₁ , CS ₀ , CS ₁ , CS ₂ , CA ₁ , CB ₁ , E			-	-	10	
Output Capacitance	\overline{IRQA} , \overline{IROB}	C_{out}	$V_{in} = 0V$, $T_a = 25^\circ C$, $f = 1.0MHz$	-	-	10	pF

* $T_a = 25^\circ C$, $V_{CC} = 5.0V$

** HD68B21: $V_{OH} = 2.2V$ min (PA₀~PA₇, CA₂)

● AC CHARACTERISTICS ($V_{CC}=5.0V\pm 5\%$, $V_{SS}=0$, $T_a=-20\sim+75^\circ C$, unless otherwise noted.)

1. PERIPHERAL TIMING

Item	Symbol	Test Condition	HD6821		HD68A21		HD68B21		Unit
			min	max	min	max	min	max	
Peripheral Data Setup Time	t_{PDSU}	Fig. 1	200	—	135	—	100	—	ns
Peripheral Data Hold Time	t_{PDH}	Fig. 1	0	—	0	—	0	—	ns
Delay Time, Enable negative transition to CA_2 negative transition	Enable $\rightarrow CA_2$ Negative t_{CA2}	Fig. 2, Fig. 3	—	1.0	—	0.67	—	0.5	μs
Delay Time, Enable negative transition to CA_2 positive transition	Enable $\rightarrow CA_2$ Positive t_{RS1}	Fig. 2	—	1.0	—	0.67	—	0.5	μs
Rise and Fall Times for CA_1 and CA_2 input signals	CA_1, CA_2 t_r, t_f	Fig. 3	—	1.0	—	1.0	—	1.0	μs
Delay Time from CA_1 active transition to CA_2 positive transition	$CA_1 \rightarrow CA_2$ t_{RS2}	Fig. 3	—	2.0	—	1.35	—	1.0	μs
Delay Time, Enable negative transition to Peripheral Data Valid	Enable \rightarrow Peripheral Data t_{PDW}	Fig. 4, Fig. 5	—	1.0	—	0.67	—	0.5	μs
Delay Time, Enable negative transition to Peripheral CMOS Data Valid	Enable \rightarrow Peripheral Data $PA_0 \sim PA_7, CA_2$ t_{CMOS}	$V_{CC} - 30\% V_{CC}$ Fig. 4	—	2.0	—	1.35	—	1.0	μs
Delay Time, Enable positive transition to CB_2 negative position	Enable $\rightarrow CB_2$ t_{CB2}	Fig. 6, Fig. 7	—	1.0	—	0.67	—	0.5	μs
Delay Time, Peripheral Data Valid to CB_2 negative transition	Peripheral Data $\rightarrow CB_2$ t_{DC}	Fig. 5	20	—	20	—	20	—	ns
Delay Time, Enable positive transition to CB_2 positive transition	Enable $\rightarrow CB_2$ t_{RS1}	Fig. 6	—	1.0	—	0.67	—	0.5	μs
Peripheral Control Output Pulse Width, CA_2 / CB_2	CA_2, CB_2 PW_{CT}	Fig. 2, Fig. 6	550	—	550	—	500	—	ns
Rise and Fall Time for CB_1 and CB_2 input signals	CB_1, CB_2 t_r, t_f	Fig. 7	—	1.0	—	1.0	—	1.0	μs
Delay Time, CB_1 active transition to CB_2 positive transition	$CB_1 \rightarrow CB_2$ t_{RS2}	Fig. 7	—	2.0	—	1.35	—	1.0	μs
Interrupt Release Time, $IRQA$ and $IRQB$	$IRQA, IRQB$ t_{IR}	Fig. 9	—	1.6	—	1.1	—	0.85	μs
Interrupt Response Time	$IRQA, IRQB$ t_{RS3}	Fig. 8	—	1.0	—	1.0	—	1.0	μs
Interrupt Input Pulse Width	CA_1, CA_2, CB_1, CB_2 PWI	Fig. 8	500**	—	500**	—	500**	—	ns
Reset "Low" Time	RES^* t_{RL}	Fig. 10	1.0	—	0.66	—	0.5	—	μs

* The Reset line must be "High" a minimum of 1.0 μs before addressing the PIA.

** At least one Enable "High" pulse should be included in this period.

2. BUS TIMING

1) READ

Item	Symbol	Test Condition	HD6821		HD68A21		HD68B21		Unit
			min	max	min	max	min	max	
Enable Cycle Time	t_{cycE}	Fig. 11	1000	—	666	—	500	—	ns
Enable Pulse Width, "High"	PW_{EH}	Fig. 11	450	—	280	—	220	—	ns
Enable Pulse Width, "Low"	PW_{EL}	Fig. 11	430	—	280	—	210	—	ns
Enable Pulse Rise and Fall Times	t_{Er}, t_{Ef}	Fig. 11	—	25	—	25	—	25	ns
Setup Time	Address, R/\bar{W} —Enable t_{AS}	Fig. 12	140	—	140	—	70	—	ns
Address Hold Time	t_{AH}	Fig. 12	10	—	10	—	10	—	ns
Data Delay Time	t_{DDR}	Fig. 12	—	320	—	220	—	180	ns
Data Hold Time	t_{DHR}	Fig. 12	10	—	10	—	10	—	ns

2) WRITE

Item	Symbol	Test Condition	HD6821		HD68A21		HD68B21		Unit
			min	max	min	max	min	max	
Enable Cycle Time	t_{cycE}	Fig. 11	1000	—	666	—	500	—	ns
Enable Pulse Width, "High"	PW_{EH}	Fig. 11	450	—	280	—	220	—	ns
Enable Pulse Width, "Low"	PW_{EL}	Fig. 11	430	—	280	—	210	—	ns
Enable Pulse Rise and Fall Times	t_{Er}, t_{Ef}	Fig. 11	—	25	—	25	—	25	ns
Setup Time	t_{AS}	Fig. 13	140	—	140	—	70	—	ns
Address Hold Time	Address, R/ \bar{W} -Enable	t_{AH}	10	—	10	—	10	—	ns
Data Setup Time	t_{DSW}	Fig. 13	195	—	80	—	60	—	ns
Data Hold Time	t_{DHW}	Fig. 13	10	—	10	—	10	—	ns

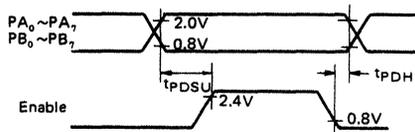
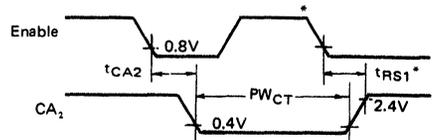


Figure 1 Peripheral Data Setup and Hold Times (Read Mode)



* Assumes part was deselected during the previous E pulse.

Figure 2 CA₂ Delay Time (Read Mode; CRA5=CRA3=1, CRA4=0)

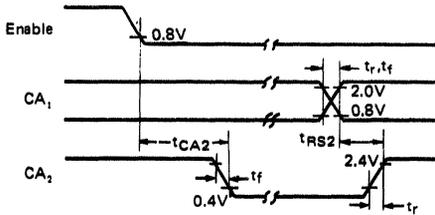


Figure 3 CA₂ Delay Time (Read Mode; CRA5=1, CRA3=CRA4=0)

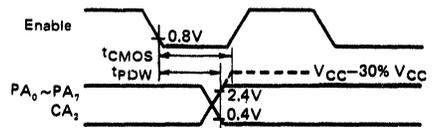
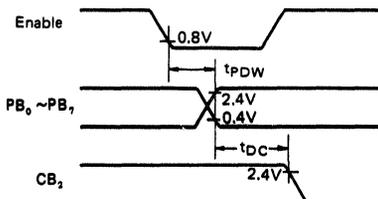
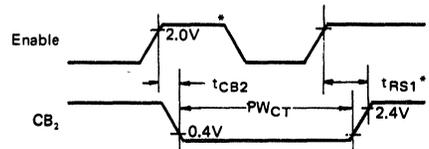


Figure 4 Peripheral CMOS Data Delay Times (Write Mode; CRA5=CRA3=1, CRA4=0)



(Note) CB₂ goes "Low" as a result of the positive transition of Enable.

Figure 5 Peripheral Data and CB₂ Delay Times (Write Mode; CRB5=CRB3=1, CRB4=0)



* Assumes part was deselected during the previous E pulse.

Figure 6 CB₂ Delay Time (Write Mode; CRB5=CRB3=1, CRB4=0)

■ PIA INTERFACE SIGNALS FOR MPU

The PIA interfaces to the HD6800 MPU with an eight-bit bi-directional data bus, three chip select lines, two register select lines, two interrupt request lines, read/write line, enable line and reset line. These signals, in conjunction with the HD6800 VMA output, permit the MPU to have complete control over the PIA. VMA should be utilized in conjunction with an MPU address line into a chip select of the PIA.

• PIA Bi-Directional Data ($D_0 \sim D_7$)

The bi-directional data lines ($D_0 \sim D_7$) allow the transfer of data between the MPU and the PIA. The data bus output drivers are three-state devices that remain in the high-impedance (off) state except when the MPU performs a PIA read operation. The R/\bar{W} line is in the Read ("High") state when the PIA is selected for a Read operation.

• PIA Enable (E)

The enable pulse, E, is the only timing signal that is supplied to the PIA. Timing of all other signals is referenced to the leading and trailing edges of the E pulse. This signal will normally be a derivative of the HMCS6800 System ϕ_2 Clock. This signal must be continuous clock pulse.

• PIA Read/Write (R/\bar{W})

This signal is generated by the MPU to control the direction of data transfers on the Data Bus. A "Low" state on the PIA line enables the input buffers and data is transferred from the MPU to the PIA on the E signal if the device has been selected. A "High" on the R/\bar{W} line sets up the PIA for a transfer of data to the bus. The PIA output buffers are enabled when the proper address and the enable pulse E are present.

• Reset (\bar{RES})

The active "Low" \bar{RES} line is used to reset all register bits in the PIA to a logical zero "Low". This line can be used as a power-on reset and as a master reset during system operation.

• PIA Chip Select (CS_0 , CS_1 and \bar{CS}_2)

These three input signals are used to select the PIA. CS_0 and CS_1 must be "High" and \bar{CS}_2 must be "Low" for selection of the device. Data transfers are then performed under the control of the E and R/\bar{W} signals. The chip select lines must be stable for the duration of the E pulse. The device is deselected when any of the chip selects are in the inactive state.

• PIA Register Select (RS_0 and RS_1)

The two register select lines are used to select the various registers inside the PIA. These two lines are used in conjunction with internal Control Registers to select a particular register that is to be written or read.

The register and chip select lines should be stable for the duration of the E pulse while in the read or write cycle.

• Interrupt Request (\bar{IRQA} and \bar{IRQB})

The active "Low" Interrupt Request lines (\bar{IRQA} and \bar{IRQB}) act to interrupt the MPU either directly or through interrupt priority circuitry. These lines are "open drain" (no load device on the chip). This permits all interrupt request lines to be tied together in a wire-OR configuration.

Each \bar{IRQ} line has two internal interrupt flag bits that can cause the \bar{IRQ} line to go "Low". Each flag bit is associated with a particular peripheral interrupt line. Also four interrupt enable bits are provided in the PIA which may be used to inhibit a particular interrupt from a peripheral device.

Servicing an interrupt by the MPU may be accomplished by a software routine that, on a prioritized basis, sequentially reads and tests the two control registers in each PIA for interrupt flag bits that are set.

The interrupt flags are cleared (zeroed) as a result of an MPU Read Peripheral Data Operation of the corresponding data register. After being cleared, the interrupt flag bit cannot be enabled to be set until the PIA is deselected during an E pulse. The E pulse is used to condition the interrupt control lines (CA_1 , CA_2 , CB_1 , CB_2). When these lines are used as interrupt inputs at least one E pulse must occur from the inactive edge to the active edge of the interrupt input signal to condition the edge sense network. If the interrupt flag has been enabled and the edge sense circuit has been properly conditioned, the interrupt flag will be set on the next active transition of the interrupt input pin.

■ PIA PERIPHERAL INTERFACE LINES

The PIA provides two 8-bit bi-directional data buses and four interrupt/control lines for interfacing to peripheral devices.

• Section A Peripheral Data ($PA_0 \sim PA_7$)

Each of the peripheral data lines can be programmed to act as an input or output. This is accomplished by setting a "1" in the corresponding Data Direction Register bit for those lines which are to be outputs. A "0" in a bit of the Data Direction Register causes the corresponding peripheral data line to act as an input. During an MPU Read Peripheral Data Operation, the data on peripheral lines programmed to act as inputs appears directly on the corresponding MPU Data Bus lines.

The data in Output Register A will appear on the data lines that are programmed to be outputs. A logical "1" written into the register will cause a "High" on the corresponding data line while a "0" results in a "Low". Data in Output Register A may be read by an MPU "Read Peripheral Data A" operation when the corresponding lines are programmed as outputs. This data will be read properly if the voltage on the peripheral data lines is greater than 2.0 volts for a logic "1" output and less than 0.8 volt for a logic "0" output. Loading the output lines such that the voltage on these lines does not reach full voltage causes the data transferred into the MPU on a Read operation to differ from that contained in the respective bit of Output Register A.

• Section B Peripheral Data ($PB_0 \sim PB_7$)

The peripheral data lines in the B Section of the PIA can be programmed to act as either inputs or outputs in a similar manner to $PA_0 \sim PA_7$. However, the output buffers driving these lines differ from those driving lines $PA_0 \sim PA_7$. They have three-state capability, allowing them to enter a high impedance state when the peripheral data line is used as an input. In addition, data on the peripheral data lines $PB_0 \sim PB_7$ will be read properly from those lines programmed as outputs even if the voltages are below 2.0 volts for a "High". As outputs, these lines are compatible with standard TTL and may also be used as a source of up to 2.5 milliampere (typ.) at 1.5 volts to directly drive the base of a transistor switch.

• Interrupt Input (CA_1 and CB_1)

Peripheral Input lines CA_1 and CB_1 are input only lines that set the interrupt flags of the control registers. The active transition for these signals is also programmed by the two control registers.

• Peripheral Control (CA_2)

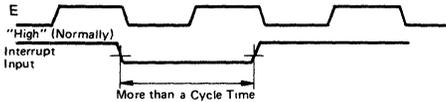
The peripheral control line CA_2 can be programmed to act as an interrupt input or as a peripheral control output. As an output, this line is compatible with standard TTL. The function of this signal line is programmed with Control Register A.

• Peripheral Control (CB_2)

Peripheral Control line CB_2 may also be programmed to act as an interrupt input or peripheral control output. As an input,

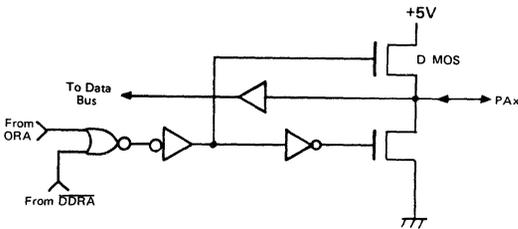
this line has "High" input impedance and is compatible with standard TTL. As an output it is compatible with standard TTL and may also be used as a source of up to 2.5 milliampere (typ) at 1.5 volts to directly drive the base of a transistor switch. This line is programmed by Control Register B.

- (NOTE) 1. Interrupt inputs CA₁, CA₂, CB₁ and CB₂ shall be used at normal "High" level. When interrupt inputs are "Low" at reset (RES = "Low"), interrupt flags CRA6, CRA7, CRB6 and CRB7 may be set.
2. Pulse width of interrupt inputs CA₁, CA₂, CB₁ and CB₂ shall be greater than a E cycle time. In the case that "High" time of E signal is not contained in Interrupt pulse, an interrupt flag may not be set.

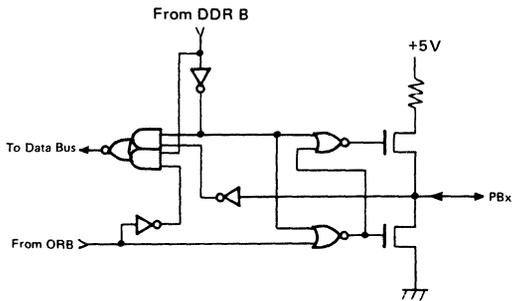


• The equivalent Circuit of the Lines on Peripheral side

The equivalent circuit of the lines on Peripheral side is shown in Fig. 15. The output circuits of A port is different from that of B port. When the port is used as input, the input is pullup to V_{CC} side through load MOS in A port and B port becomes "Off" (high impedance).



(a) Section A



(b) Section B

Figure 15 Peripheral Data Bus

■ INTERNAL CONTROLS

There are six locations within the PIA accessible to the MPU data bus: two Peripheral Registers, two Data Direction Registers, and two Control Registers. Selection of these locations is controlled by the RS₀ and RS₁ inputs together with bit 2 in the Control Register, as shown in Table 1.

Table 1 Internal Addressing

RS ₁	RS ₀	Control Register Bit		Location Selected
		CRA2	CRB2	
0	0	1	x	Peripheral Register A*
0	0	0	x	Data Direction Register A
0	1	x	x	Control Register A
1	0	x	1	Peripheral Register B*
1	0	x	0	Data Direction Register B
1	1	x	x	Control Register B

x = Don't Care

* Peripheral interface register is a generic term containing peripheral data bus and output register.

• Initialization

A "Low" reset line has the effect of zeroing all PIA registers. This will set PA₀~PA₇, PB₀~PB₇, CA₂ and CB₂ as inputs, and all interrupts disabled. The PIA must be configured during the restart program which follows the reset.

Details of possible configurations of the Data Direction and Control Register are as follows.

• Data Direction Registers (DDRA and DDRB)

The two Data Direction Registers allow the MPU to control the direction of data through each corresponding peripheral data line. A Data Direction Register bit set at "0" configures the corresponding peripheral data line as an input; a "1" results in an output.

• Control Registers (CRA and CRB)

The two Control Registers (CRA and CRB) allow the MPU to control the operation of the four peripheral control lines CA₁, CA₂, CB₁ and CB₂. In addition they allow the MPU to enable the interrupt lines and monitor the status of the interrupt flags. Bits 0 through 5 of the two registers may be written or read by the MPU when the proper chip select and register select signals are applied. Bits 6 and 7 of the two registers are read only and are modified by external interrupts occurring on control lines CA₁, CA₂, CB₁ or CB₂. The format of the control words is shown in Table 2.

Table 2 Control Word Format

	7	6	5	4	3	2	1	0
CRA	IRQA1	IRQA2	CA ₂ Control			DDRA Access	CA ₁ Control	
CRB	IRQB1	IRQB2	CB ₂ Control			DDRB Access	CB ₁ Control	

Data Direction Access Control Bit (CRA2 and CRB2)

Bit 2 in each Control register (CRA and CRB) allows selection of either a Peripheral Interface Register or the Data Direction Register when the proper register select signals are applied to RS₀ and RS₁.

Interrupt Flags (CRA6, CRA7, CRB6, and CRB7)

The four interrupt flag bits are set by active transitions of signals on the four Interrupt and Peripheral Control lines when those lines are programmed to be inputs. These bits cannot be set directly from the MPU Data Bus and are reset indirectly by a Read Peripheral Data Operation on the appropriate section.

Control of CA₁ and CB₁ Interrupt Lines (CRA0, CRB0, CRA1, and CRB1)

The two lowest order bits of the control registers are used to control the interrupt input lines CA₁ and CB₁. Bits CRA0 and

CRB0 are used to enable the MPU interrupt signals \overline{IRQA} and \overline{IRQB} , respectively. Bits CRA1 and CRB1 determine the active transition of the interrupt input signals CA₁ and CB₁ (Table 3)
Control of CA₂ and CB₂ Peripheral Control Lines (CRA3, CRA4, CRA5, CRB3, CRB4, and CRB5)

Bits 3, 4 and 5 of the two control registers are used to control the CA₂ and CB₂ Peripheral Control lines. These bits determine if the control lines will be an interrupt input or an output control signal. If bit CRA5 (CRB5) is "0" CA₂ (CB₂) is an interrupt input line similar to CA₁ (CB₁) (Table 4). When CRA5 (CRB5) is "1", CA₂ (CB₂) becomes an output signal that may be used to control peripheral data transfers. When in the output mode, CA₂ and CB₂ have slightly different characteristics (Table 5 and 6).

Table 3 Control of Interrupt Inputs CA₁ and CB₁

CRA1 (CRB1)	CRA0 (CRB0)	Interrupt Input CA ₁ (CB ₁)	Interrupt Flag CRA7 (CRB7)	MPU Interrupt Request \overline{IRQA} (\overline{IRQB})
0	0	↓ Active	Set "1" on ↓ of CA ₁ (CB ₁)	Disabled – \overline{IRQ} remains "High"
0	1	↓ Active	Set "1" on ↓ of CA ₁ (CB ₁)	Goes "Low" when the interrupt flag bit CRA7 (CRB7) goes "1"
1	0	↑ Active	Set "1" on ↑ of CA ₁ (CB ₁)	Disabled – \overline{IRQ} remains "High"
1	1	↑ Active	Set "1" on ↑ of CA ₁ (CB ₁)	Goes "Low" when the interrupt flag bit CRA7 (CRB7) goes "1"

- (Notes)
- ↑ indicates positive transition ("Low" to "High")
 - ↓ indicates negative transition ("High" to "Low")
 - The interrupt flag bit CRA7 is cleared by an MPU Read of the A Peripheral Register and CRB7 is cleared by an MPU Read of the B Peripheral Register.
 - If CRA0 (CRB0) is "0" when an interrupt occurs (Interrupt disabled) and is later brought "1", \overline{IRQA} (\overline{IRQB}) occurs after CRA0 (CRB0) is written to a "1".

Table 4 Control of CA₂ and CB₂ as Interrupt Inputs – CRA5 (CRB5) is "0"

CRA5 (CRB5)	CRA4 (CRB4)	CRA3 (CRB3)	Interrupt Input CA ₂ (CB ₂)	Interrupt Flag CRA6 (CRB6)	MPU Interrupt Request \overline{IRQA} (\overline{IRQB})
0	0	0	↓ Active	Set "1" on ↓ of CA ₂ (CB ₂)	Disabled – \overline{IRQ} remains "High"
0	0	1	↓ Active	Set "1" on ↓ of CA ₂ (CB ₂)	Goes "Low" when the interrupt flag bit CRA6 (CRB6) goes "1"
0	1	0	↑ Active	Set "1" on ↑ of CA ₂ (CB ₂)	Disabled – \overline{IRQ} remains "High"
0	1	1	↑ Active	Set "1" on ↑ of CA ₂ (CB ₂)	Goes "Low" when the interrupt flag bit CRA6 (CRB6) goes "1"

- (Notes)
- ↑ indicates positive transition ("Low" to "High")
 - ↓ indicates negative transition ("High" to "Low")
 - The interrupt flag bit CRA6 is cleared by an MPU Read of the A Peripheral Register and CRB6 is cleared by an MPU Read of the B Peripheral Register.
 - If CRA3 (CRB3) is "0" when an interrupt occurs (Interrupt disabled) and is later brought "1", \overline{IRQA} (\overline{IRQB}) occurs after CRA3 (CRB3) is written to a "1".

Table 5 Control of CB₂ as an Output – CRB5 is "1"

CRB5	CRB4	CRB3	CB ₂	
			Cleared	Set
1	0	0	"Low" on the positive transition of the first E pulse after MPU Write "B" Data Register operation.	"High" when the interrupt flag bit CRB7 is set by an active transition of the CB ₁ signal. (See Figure 16)
1	0	1	"Low" on the positive transition of the first E pulse after an MPU Write "B" Data Register operation.	"High" on the positive edge of the first "E" pulse following an "E" pulse which occurred while the part was deselected. (See Figure 16)
1	1	0	"Low" (The content of CRB3 is output on CB ₂)	
1	1	1	"High" (The content of CRB3 is output on CB ₂)	

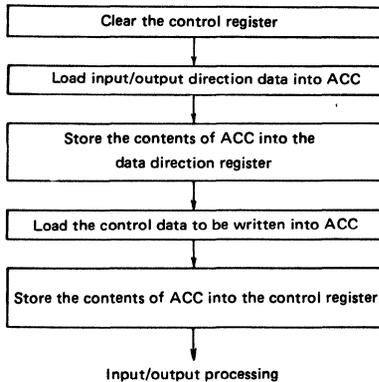
Table 6 Control of CA₂ as an Output – CRA5 is "1"

CRA5	CRA4	CRA3	CA ₂	
			Cleared	Set
1	0	0	"Low" on negative transition of E after an MPU Read "A" Data Operation.	"High" when the interrupt flag bit CRA7 is set by an active transition of the CA ₁ signal. (See Figure 16)
1	0	1	"Low" on negative transition of E after an MPU Read "A" Data operation.	"High" on the negative edge of the first "E" pulse which occurs during a deselect. (See Figure 16)
1	1	0	"Low" (The content of CRA3 is output on CA ₂)	
1	1	1	"High" (The content of CRA3 is output on CA ₂)	

■ PIA OPERATION

● Initialization

When the external reset input \overline{RES} goes "Low", all internal registers are cleared to "0". Peripheral data port (PA₀~PA₇, PB₀~PB₇) is defined to be input and control lines (CA₁, CA₂, CB₁ and CB₂) are defined to be the interrupt input lines. PIA is also initialized by software sequence as follows.

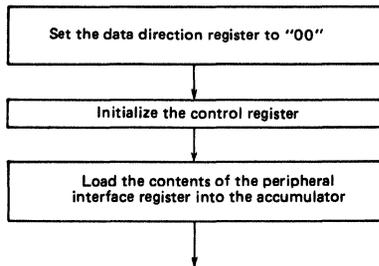


- Program the data direction register access bit of the control register to "0" to allow to access the data direction register.

- The data of the control line function is set into the accumulator, of which Data Direction Register Access Bit shall be programmed to "1".
- Transfer the control data from the accumulator into the control register.

● Read/Write Operation Not Using Control Lines

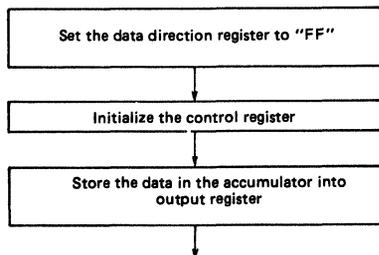
<Read Operation>



CLR CRA
 CLR DDRA
 LDAA #\$04
 STAA CRA
 LDAA PIRA

- Clear the DDRA access bit of the control register to "0".
- Clear all bits of the data direction register.
- Set DDRA access bit of the control register to "1" to allow to access the peripheral interface register.

<Write Operation>



CLR CRA
 LDAA #\$FF
 STAA DDRB
 LDAA #\$04
 STAA CRB
 LDAA DATA
 STAA PIRB

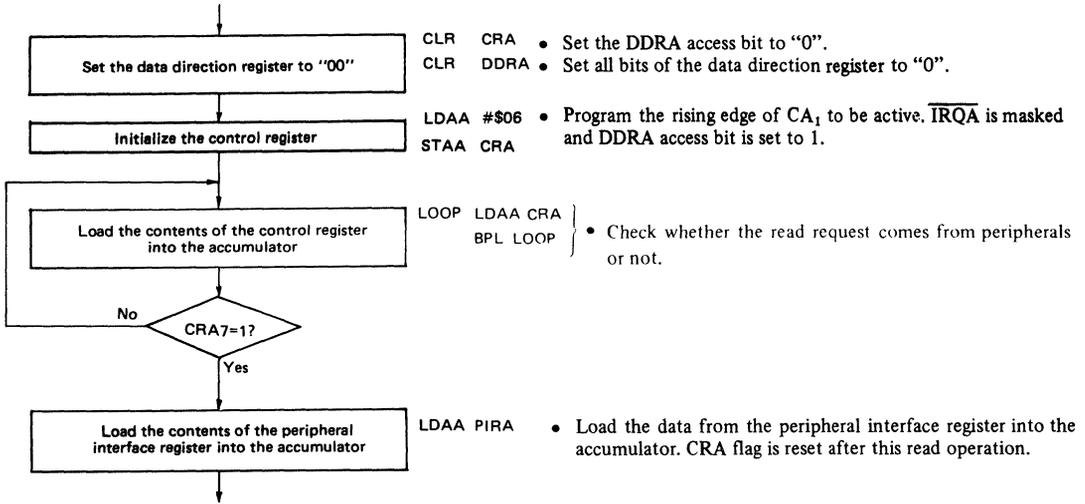
- Set DDRB access bit of the control register to "0".
- Set all bits of the data direction register to "FF".
- Set DDRB access bit of the control register to "1" to allow to access the peripheral interface register.
- Write the data into the peripheral interface register.

• **Read/Write Operating Using Control Lines**

Read/write request from peripherals shall be put into the control lines as an interrupt signal, and then MPU reads or writes after detecting interrupt request.

< Read >

The following case is that Port A is used and that the rising edge of CA₁ indicates the request for read from peripherals.

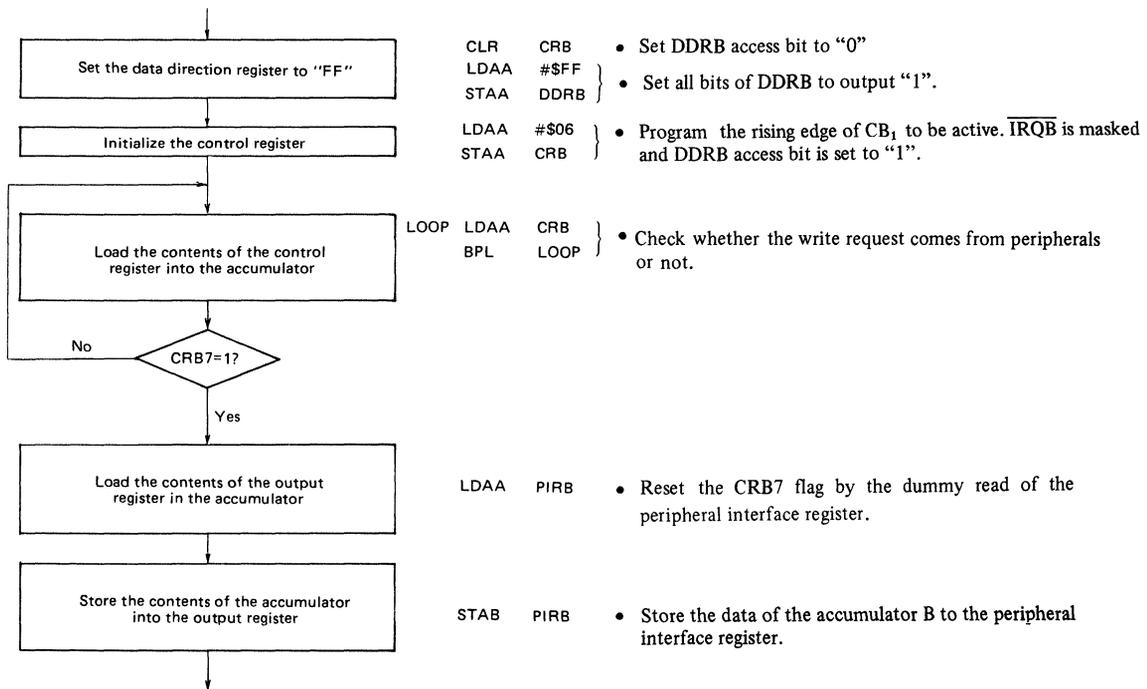


To read the peripheral data, the data is directly transferred to the data buses D₀~D₇ through PA₀~PA₇ or PB₀~PB₇, and they are not latched in the PIA. If necessary, the data should be held in the external latch until MPU completes reading it.

When initializing the control register, interrupt flag bit (CRA7, CRA6, CRB7, CRB6) cannot be written from MPU. If necessary the interrupt flag must be reset by dummy read of Peripheral Register A and B.

< Write >

Write operation using the interrupt signal is as follows. In this case, B port is used and interrupt request is input to CB₁. And the IRQ flag is set at the rising edge of CB₁.



Interrupt request flag bits (CRA7, CRA6, CRB7 and CRB6) cannot be written and they cannot be also reset by write operation to the peripheral interface register. So dummy read of peripheral interface register is needed to reset the flags.

To accept the next interrupt, it is essential to reset indirectly the interrupt flag by dummy read of peripheral interface register.

Software polling method mentioned above requires MPU to continuously monitor the control register to detect the read/write request from peripherals. So other programs cannot run at the same time. To avoid this problem, hardware interrupt may be used. The MPU is interrupted by \overline{IRQA} or \overline{IRQB} when the read/write request is occurred from peripherals and then MPU analyzes cause of the interrupt request during interrupt processing.

• **Handshake Mode**

The functions of CRA and CRB are similar but not identical in the hand-shake modes. Port A is used for read hand-shake operation and Port B is used for write hand-shake mode.

CA₁ and CB₁ are used for interrupt input requests and CA₂ and CB₂ are control outputs (answer) in hand-shake mode.

Fig. 16, Fig. 17 and Fig. 18 show the timing of hand-shake mode.

< **Read Hand-shake Mode** >

CRA5="1", CRA4="0" and CRA3="0"

- ① A peripheral device puts the 8-bit data on the peripheral data lines after the control output CA₂ goes "Low".
- ② The peripheral requests MPU to read the data by using CA₁ input.

- ③ CRA7 flag is set and CA₂ becomes "High" (CA₂ automatically becomes "High" by the interrupt CA₁). This indicates the peripheral to maintain the current data and not to transfer the next data.
- ④ MPU accepts the read request by \overline{IRQA} hardware interrupt or CRA read. Then MPU reads the peripheral register A.
- ⑤ CA₂ goes "Low" on the following edge of read Enable pulse. This informs that the peripheral can set the next data to port A.

< **Write Hand-shake** >

CRB5 = "1", CRB4 = "0" and CRB3 = "0"

- ① A peripheral device requests MPU to write the data by using CB₁ input. CB₂ output remains "High" until MPU write data to the peripheral interface register.
- ② CRB7 flag is set and MPU accepts the write request.
- ③ MPU reads the peripheral interface register to reset CRB7 (dummy read).
- ④ Then MPU write data to the peripheral interface register. The data is output to port B through the output register.
- ⑤ CB₂ automatically becomes "Low" to tell the peripheral that new data is on port B.
- ⑥ The peripheral read the data on Port B peripheral data lines and set CB₁ to "Low" to tell MPU that the data on the peripheral data lines has been taken and that next data can be written to the peripheral interface register.

< **Pulse mode** >

CRA5 = "1", CRA4 = "0" and CRA3 = "1"

CRB5 = "1", CRB4 = "0" and CRB3 = "1"

This mode is shown in Figure 16, Figure 19 and Figure 20.

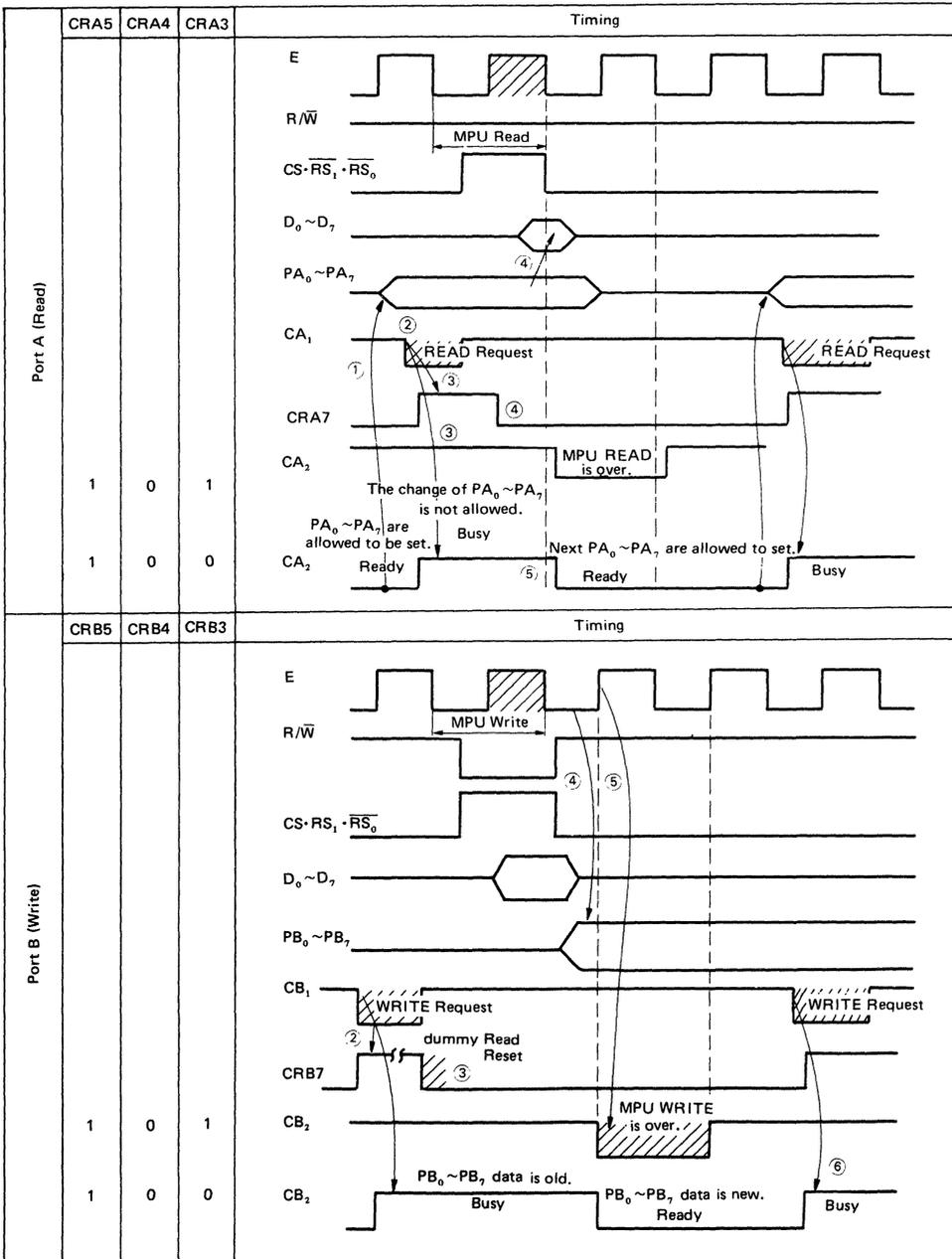


Figure 16 Timing of Hand-shake Mode and Pulse Mode

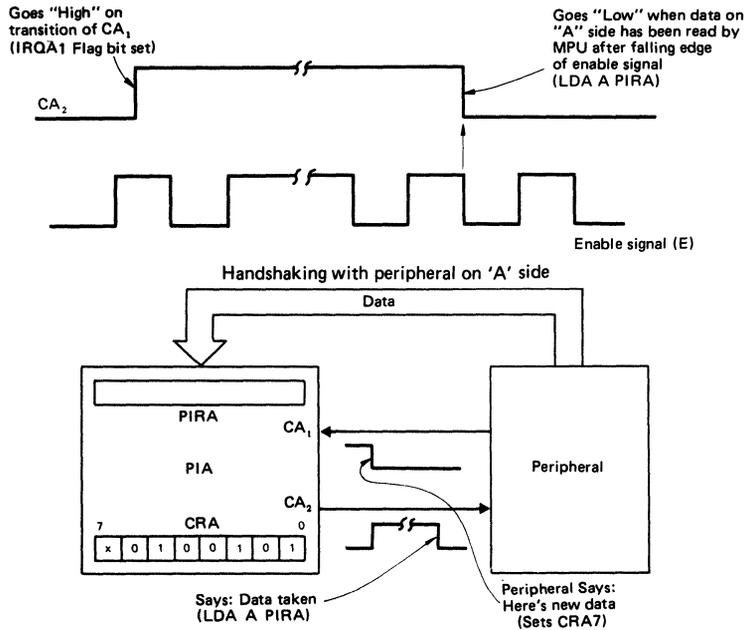


Figure 17 Bits 5, 4, 3 of CRA = 100 (Hand-shake Mode)

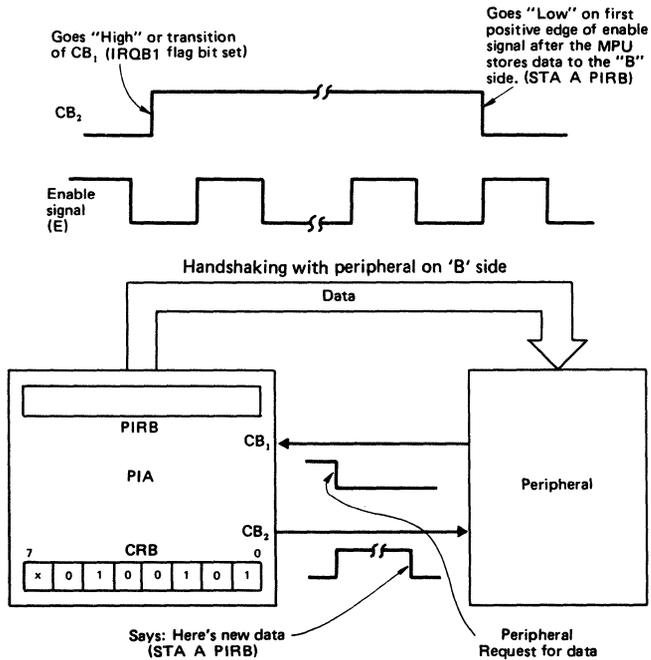


Figure 18 Bits 5, 4, 3 of CRB = 100 (Hand-shake Mode)

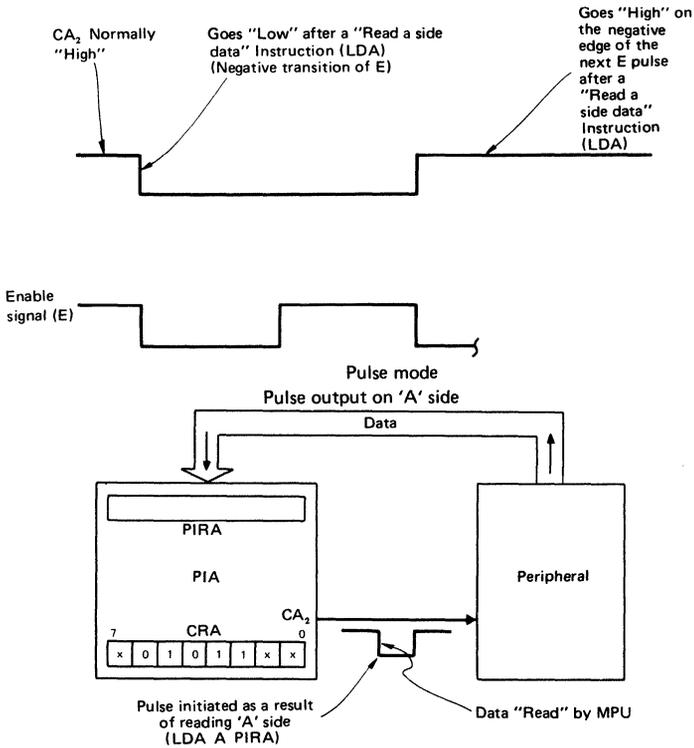


Figure 19 Bits 5, 4, 3 of CRA = 101 (Pulse Mode)

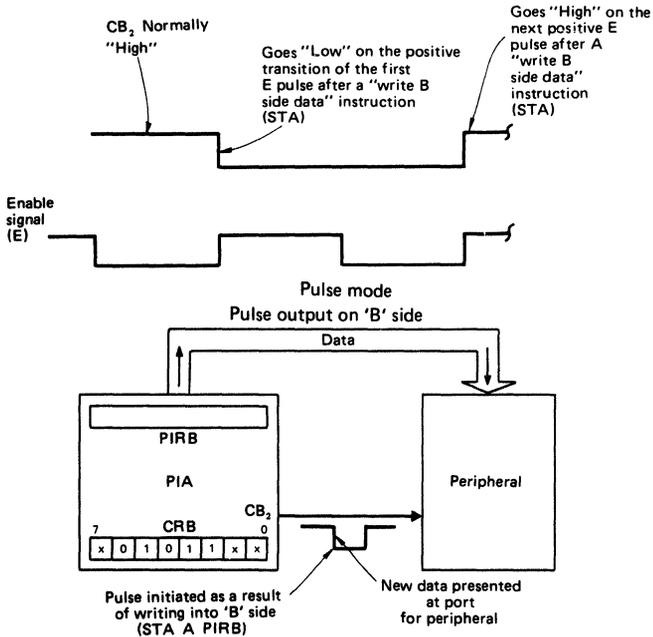


Figure 20 Bits 5, 4, 3 of CRB=101 (Pulse Mode)

■ SUMMARY OF CONTROL REGISTERS CRA AND CRB

Control registers CRA and CRB have total control of CA₁, CA₂, CB₁, and CB₂ lines. The status of eight bits of the control registers may be read into the MPU. However, the MPU can only write into Bit 0 through Bit 5 (6 bits), since Bit 6 and Bit 7 are set only by CA₁, CA₂, CB₁, or CB₂.

● Addressing PIAs

Before addressing PIAs, the data direction (DDR) must first be loaded with the bit pattern that defines how each line is to function, i.e., as an input or an output. A logic "1" in the data direction register defines the corresponding line as an output while a logic "0" defines the corresponding line as an input. Since the DDR and the peripheral interface register have the same address, the control register bit 2 determines which register is being addressed. If Bit 2 in the control register is a logic "0", then the DDR is addressed. If Bit 2 in the control register is a logic "1", the peripheral interface register is addressed. Therefore, it is essential that the DDR be loaded first before setting Bit 2 of the control register.

<Example>

Given a PIA with an address of 4004, 4005, 4006, and 4007. 4004 is the address of the A side peripheral interface register. 4005 is the address of the A side control register. 4006 is the address of the B side peripheral interface register. 4007 is the address of the B side control register. On the A side, Bits 0, 1, 2, and 3 will be defined as inputs, while Bits 4, 5, 6, and 7 will be used as outputs. On the B side, all lines will be used as outputs.

PIA1AD = 4004 (DDRA, PIRA)
 PIA1AC = 4005 (CRA)
 PIA1BD = 4006 (DDRB, PIRB)
 PIA1BC = 4007 (CRB)

1. LDA A #%11110000 (4 outputs, 4 inputs)
2. STA A PIA1AD (Loads A DDR)
3. LDA A #%11111111 (All outputs)
4. STA A PIA1BD (Loads B DDR)
5. LDA A #%00000100 (Sets Bit 2)
6. STA A PIA1AC (Bit 2 set in A control register)
7. STA A PIA1BC (Bit 2 set in B control register)

Statement 2 addresses the DDR, since the control register (Bit 2) has not been loaded. Statements 6 and 7 load the control registers with Bit 2 set, so addressing PIA1AD or PIA1BD accesses the peripheral interface register.

● PIA Programming Via The Index Register

The program shown in the previous section can be accomplished using the Index Register.

1. LDX #\$F004
2. STX PIA1AD \$F0→PIA1AD;\$04→PIA1AC
3. LDX #\$FF04
4. STX PIA1BD \$FF→PIA1BD;\$04→PIA1BC

Using the index register in this example has saved six bytes of program memory as compared to the program shown in the previous section.

● Active Low Outputs

When all the outputs of given PIA port are to be active "Low" (True ≤ 0.4 volts), the following procedure should be used.

- a) Set Bit 2 in the control register.
- b) Store all 1s (\$FF) in the peripheral interface register.
- c) Clear Bit 2 in the control register.
- d) Store all 1s (\$FF) in the data direction register.
- e) Store control word (Bit 2 = 1) in control register.

<Example>

The B side of PIA1 is set up to have all active low outputs. CB₁ and CB₂ are set up to allow interrupts in the HANDSHAKE MODE and CB₁ will respond to positive edges ("Low"-to-"High" transitions). Assume reset conditions. Addresses are set up and equated to the same labels as previous example.

1. LDA A #4
2. STA A PIA1BC Set Bit 2 in PIA1BC (control register)
3. LDA B #\$FF
4. STA B PIA1BD All 1s in peripheral interface register
5. CLR PIA1BC Clear Bit 2
6. STA B PIA1BD All 1s in data direction register
7. LDA A #\$27
8. STA A PIA1BC 00100111→ control register

The above procedure is required in order to avoid outputs going "Low", to the active "Low" TRUE STATE, when all 1s are stored to the data direction register as would be the case if the normal configuration procedure were followed.

● Interchanging RS₀ And RS₁

Some system applications may require movement of 16 bits of data to or from the "outside world" via two PIA ports (A side + B side). When this is the case it is an advantage to interconnect RS₁ and RS₀ as follows.

RS₀ to A1 (Address Line A1)
 RS₁ to A0 (Address Line A0)

This will place the peripheral interface registers and control registers side by side in the memory map as follows.

Table	Example Address	
PIA1AD	\$4004	(DDRA, PIRA)
PIA1BD	\$4005	(DDRB, PIRB)
PIA1AC	\$4006	(CRA)
PIA1BC	\$4007	(CRB)

The index register or stackpointer may be used to move the 16-bit data in two 8-bit bytes with one instruction. As an example:

LDX PIA1AD PIA1AD → IX_H; PIA1BD → IX_L

● PIA - After Reset

When the \overline{RES} (Reset Line) has been held "Low" for a minimum of one microsecond, all registers in the PIA will be cleared.

Because of the reset conditions, the PIA has been defined as

follows.

1. All I/O lines to the "outside world" have been defined as inputs.
2. CA₁, CA₂, CB₁, and CB₂ have been defined as interrupt input lines that are negative edge sensitive.
3. All the interrupts on the control lines are masked. Setting of interrupt flag bits will not cause \overline{IRQA} or \overline{IRQB} to go "Low".

■ SUMMARY OF CA₁-CB₁ PROGRAMMING

Bits 1 and 0 of the respective control registers are used to program the interrupt input control lines CA₁ and CB₁.

b1	b0	
0	0	b1 = Edge (0 = -, 1 = +)
0	1	b0 = Mask (0 = Mask, 1 = Allow)
1	0	
1	1	

■ SUMMARY OF CA₂-CB₂ PROGRAMMING

Bits 5, 4, and 3 of the control registers are used to program the operation of CA₂-CB₂.

	b5	b4	b3	
CA ₂ -CB ₂ Input Mode	0	0(-)	0 (Mask)	CA ₂ -CB ₂ Input Mode b4 = Edge (0 = -, 1 = +) b3 = Mask (0 = Mask, 1 = Allow)
	0	0(-)	1 (Allow)	
	0	1(+)	0 (Mask)	
	0	1(+)	1 (Allow)	
CA ₂ -CB ₂ Output Mode	1	0	0	b3 Following Mode 0 - Handshake Mode 1 - Pulse Mode
	1	0	1	
	1	1	0	
	1	1	1	

Note that this is the same logic as Bits 4 and 3 for CA₂-CB₂ when CA₂-CB₂ are programmed as inputs.

I/O As Follow:

Control Lines:

- CA₁ - Positive Edge, Allow Interrupt
- CA₂ - Pulse Mode
- CB₁ - Negative Edge, Mask Interrupt
- CB₂ - Hand Shake Mode

Assume Reset Condition

- PIA1AD
- PIA1AC
- PIA1BD
- PIA1BC

PIA Configuration Solution

- LDA A #\$BC 10111100
- STA A PIA1AD I/O to DDRA
- LDA A #\$FF 1111 1111
- STA A PIA1BD I/O to DDRB
- LDA A #\$2F 0010 1111
- STA A PIA1AC To "A" Control
- LDA A #\$24 0010 0100
- STA A PIA1BC To "B" Control

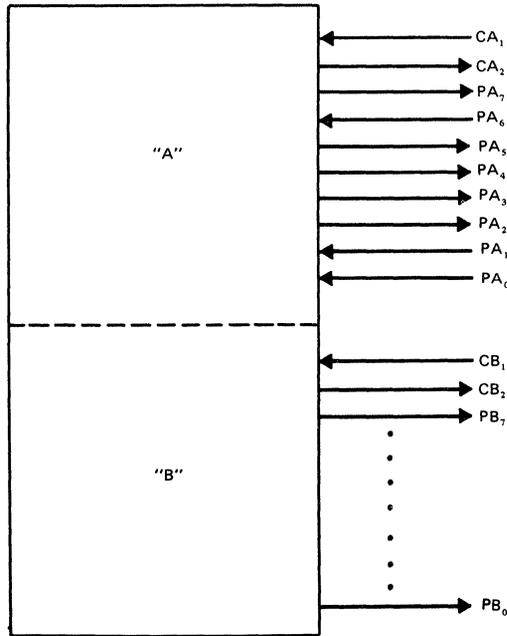


Figure 21 PIA Configuration Problem

HD6321, HD63A21, HD63B21

CMOS PIA (Peripheral Interface Adapter)

—PRELIMINARY—

The HD6321 is a CMOS Peripheral Interface Adapter provides the universal means of interfacing peripheral equipment to the HD6800 Microprocessing Unit (MPU). This device is capable of interfacing the MPU to peripherals through two 8-bit bi-directional peripheral data buses and four control lines. No external logic is required for interfacing to most peripheral devices.

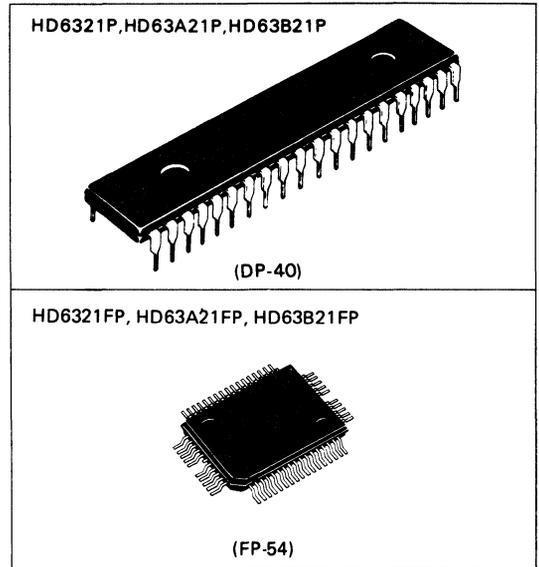
The functional configuration of the PIA is programmed by the MPU during system initialization. Each of the peripheral data lines can be programmed to act as an input or output, and each of the four control/interrupt lines may be programmed for one of several control mode. This allows a high degree of flexibility in the over-all operation of the interface. Exceeding Low power dissipation is realized due to adopting CMOS process.

■ FEATURES

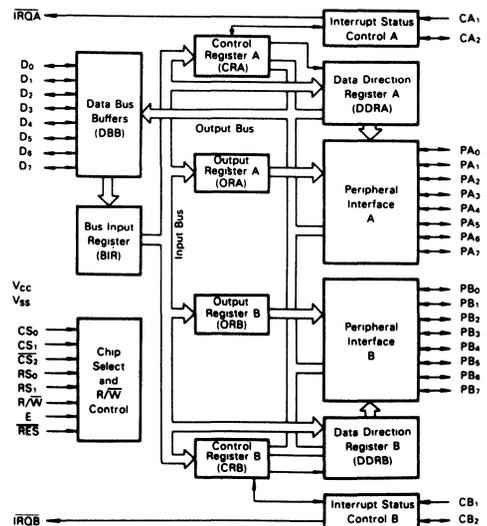
- Low-Power, High-Speed, High-Density CMOS
- Compatible with NMOS PIA (HD6821) (Refer to Electrical Specification as to Minor difference.)
- Two Bi-directional 8-Bit Peripheral Data Bus for interface to Peripheral devices
- High-Impedance 3-State and Direct Transistor Drive Peripheral Lines
- Two TTL Drive Capability on All A and B Side Buffers
- Handshake Control Logic for Input and Output Peripheral Operation

CA₁, CA₂ Port A (PA₀ ~ PA₇)
 CB₁, CB₂ Port B (PB₀ ~ PB₇)

- Two Programmable Control Registers (CRA, CRB)
- Two Programmable Data Direction Registers (DDRA, DDRB)

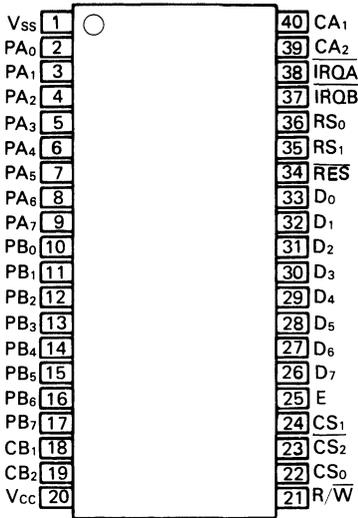


■ BLOCK DIAGRAM



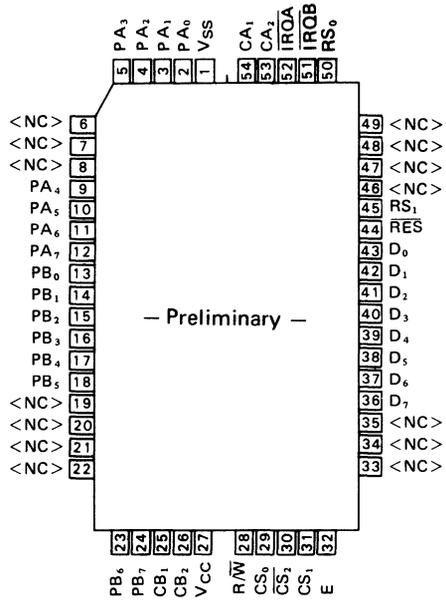
■ PIN ARRANGEMENT

- HD6321P, HD63A21P, HD63B21P



(Top View)

- HD6321FP, HD63A21FP, HD63B21FP



(Top View)

■ ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Value	Unit
Supply Voltage	V _{CC} *	-0.3 ~ +7.0	V
Input Voltage	V _{in} *	-0.3 ~ +7.0	V
Maximum Output Current	I _O **	10	mA
Maximum Total Output Current	ΣI _O ***	100	mA
Operating Temperature	T _{opr}	-20 ~ +75	°C
Storage Temperature	T _{stg}	-55 ~ +150	°C

* With respect to V_{SS} (SYSTEM GND)

** Maximum output current is the maximum current which can flow in or flow out from one output terminal and I/O common terminal. (PA₀ ~ PA₇, CA₂, PB₀ ~ PB₇, CB₂, D₀ ~ D₇)

*** Maximum total output current is the total sum of output current which can flow in or flow out simultaneously from output terminals and I/O common terminals. (PA₀ ~ PA₇, CA₂, PB₀ ~ PB₇, CB₂, D₀ ~ D₇)

(NOTE) Permanent LSI damage may occur if maximum ratings are exceeded. Normal operation should be under recommended operating conditions. If these conditions are exceeded, it could affect reliability of LSI.

■ RECOMMENDED OPERATING CONDITIONS

Item		Symbol	min	typ	max	Unit
Supply Voltage		V_{CC}^*	4.5	5.0	5.5	V
Input "Low" Voltage		V_{IL}^*	0	—	0.8	V
Input "High" Voltage	$D_0 \sim D_7, PA_0 \sim PA_7, CA_1, CA_2, PB_0 \sim PB_7, CB_1, CB_2$	V_{IH}^*	2.2	—	V_{CC}	
	$E, R/\overline{W}, CS_0, \overline{CS}_2, CS_1, RS_0, RS_1, RES$		3.0**			
Operating Temperature		T_{opr}	-20	25	75	°C

* With respect to V_{SS} (SYSTEM GND)

** Characteristics will be improved.

■ ELECTRICAL CHARACTERISTICS

● DC CHARACTERISTICS ($V_{CC}=5.0V \pm 10\%$, $V_{SS}=0V$, $T_a=-20 \sim +75^\circ C$, unless otherwise noted.)

Item		Symbol	Test Condition	min	typ	max	Unit		
Input "High" Voltage	$D_0 \sim D_7, PA_0 \sim PA_7, CA_1, CA_2, PB_0 \sim PB_7, CB_1, CB_2$	V_{IH}		2.2	—	V_{CC}	V		
	$E, R/\overline{W}, CS_0, \overline{CS}_2, CS_1, RS_0, RS_1, RES$			3.0**					
Input "Low" Voltage		V_{IL}		-0.3	—	0.8	V		
Input Leakage Current		I_{in}	$V_{in} = 0 \sim V_{CC}$	-2.5	—	2.5	μA		
Three-State (Off State) Input Current		I_{TSI}	$V_{in} = 0.4 \sim V_{CC}$	-10	—	10	μA		
Output "High" Voltage	$D_0 \sim D_7$	V_{OH}	$I_{OH} = -400 \mu A$	4.1	—	—	V		
			$I_{OH} \leq -10 \mu A$	$V_{CC} - 0.1$	—	—			
	$PA_0 \sim PA_7, CA_2, PB_0 \sim PB_7, CB_2$		$I_{OH} = -400 \mu A$	4.1	—	—			
			$I_{OH} \leq -10 \mu A$	$V_{CC} - 0.1$	—	—			
Output "Low" Voltage	$D_0 \sim D_7, \overline{IRQA}, \overline{IRQB}$	V_{OL}	$I_{OL} = 1.6mA$	—	—	0.4	V		
			$I_{OL} = 3.2mA$	—	—	0.6			
Output Leakage Current (Off State)		I_{LOH}	$V_{OH} = V_{CC}$	—	—	10	μA		
Input Capacitance	$PA_0 \sim PA_7, PB_0 \sim PB_7, CA_2, CB_2, D_0 \sim D_7$	C_{in}	$V_{in} = 0V, T_a = 25^\circ C, f = 1.0MHz$	—	—	12.5	pF		
				$R/\overline{W}, RES, RS_0, RS_1, CS_0, CS_1, \overline{CS}_2, CA_1, CB_1, E$	—	—		10	
Output Capacitance		C_{out}	$V_{in} = 0V, T_a = 25^\circ C, f = 1.0MHz$	—	—	10	pF		
Supply Current*	<ul style="list-style-type: none"> $PA_0 \sim PA_7, CA_2$ and $PB_0 \sim PB_7, CB_2$ are specified as input. Chip is not selected Input level (Except E) $V_{IH} \text{ min} = V_{CC} - 0.8V$ $V_{IL} \text{ max} = 0.8V$ 	I_{CC}		$E = 1.0MHz$	—	—	300	μA	
				$E = 1.5MHz$	—	—	400		
				$E = 2.0MHz$	—	—	500		
	<ul style="list-style-type: none"> $PA_0 \sim PA_7, CA_2$ and $PB_0 \sim PB_7, CB_2$ are specified as input. Under Data Bus R/\overline{W} operation 	I_{CC}			$E = 1.0MHz$	—	—	4	mA
					$E = 1.5MHz$	—	—	5	
					$E = 2.0MHz$	—	—	6	

* Supply current is defined on the condition that there is no current flow from output terminals. Supply current will be increased when the current from output terminal exists. Also the current will be increased for charging and discharging the capacitive load. Please take this case into consideration in estimating system power.

** Characteristics will be improved.

● AC CHARACTERISTICS (V_{CC}=5.0V±10%,V_{SS}=0, Ta=-20~+75°C, unless otherwise noted.)

1. PERIPHERAL TIMING

Item	Symbol	Test Condition	HD6321		HD63A21		HD63B21		Unit	
			min	max	min	max	min	max		
Peripheral Data Setup Time	t _{PDSU}	Fig. 1	100	—	100	—	100	—	ns	
Peripheral Data Hold Time	t _{PDH}	Fig. 1	0	—	0	—	0	—	ns	
Delay Time, Enable negative transition to CA ₂ negative transition	Enable → CA ₂ Negative	t _{CA2}	Fig. 2, Fig. 3	—	200	—	200	—	200	ns
Delay Time, Enable negative transition to CA ₂ positive transition	Enable → CA ₂ Positive	t _{RS1}	Fig. 2	—	200	—	200	—	200	ns
Rise and Fall Times for CA ₁ and CA ₂ input signals	CA ₁ , CA ₂	t _r , t _f	Fig. 3	—	100	—	100	—	100	ns
Delay Time from CA ₁ active transition to CA ₂ positive transition	CA ₁ → CA ₂	t _{RS2}	Fig. 3	—	300	—	300	—	300	ns
Delay Time, Enable negative transition to Peripheral Data Valid	Enable → Peripheral Data	t _{PDW}	Fig. 4, Fig. 5	—	300	—	300	—	300	ns
Delay Time, Enable positive transition to CB ₂ negative transition	Enable → CB ₂	t _{CB2}	Fig. 6, Fig. 7	—	200	—	200	—	200	ns
Delay Time, Peripheral Data Valid to CB ₂ negative transition	Peripheral Data → CB ₂	t _{DC}	Fig. 5	20	—	20	—	20	—	ns
Delay Time, Enable positive transition to CB ₂ positive transition	Enable → CB ₂	t _{RS1}	Fig. 6	—	200	—	200	—	200	ns
Peripheral Control Output Pulse Width, CA ₂ /CB ₂	CA ₂ , CB ₂	PW _{CT}	Fig. 2, Fig. 6	550	—	375	—	250	—	ns
Rise and Fall Time for CB ₁ and CB ₂ input signals	CB ₁ , CB ₂	t _r , t _f	Fig. 7	—	100	—	100	—	100	ns
Delay Time, CB ₁ active transition to CB ₂ positive transition	CB ₁ → CB ₂	t _{RS2}	Fig. 7	—	300	—	300	—	300	ns
Interrupt Release Time, IRQA and IRQB	IRQA, IRQB	t _{IR}	Fig. 9	—	800	—	800	—	800	ns
Interrupt Response Time	IRQA, IRQB	t _{RS3}	Fig. 8	—	400	—	400	—	400	ns
Interrupt Input Pulse Width	CA ₁ , CA ₂ , CB ₁ , CB ₂	PW _I	Fig. 8	1E cycle	—	1E cycle	—	1E cycle	—	ns
Reset "Low" Time	RES*	t _{RL}	Fig. 10	200	—	200	—	200	—	ns

* The Reset line must be "High" a minimum of 1.0μs before addressing the PIA.

** At least one Enable "High" pulse should be included in this period.

2. BUS TIMING

1) READ

Item	Symbol	Test Condition	HD6321		HD63A21		HD63B21		Unit	
			min	max	min	max	min	max		
Enable Cycle Time	t _{cycE}	Fig. 11	1000	—	666	—	500	—	ns	
Enable Pulse Width, "High"	PW _{EH}	Fig. 11	450	—	280	—	220	—	ns	
Enable Pulse Width, "Low"	PW _{EL}	Fig. 11	430	—	280	—	210	—	ns	
Enable Pulse Rise and Fall Times	t _{Er} , t _{Ef}	Fig. 11	—	25	—	25	—	20	ns	
Setup Time	Address, R/W—Enable	t _{AS}	Fig. 12	80	—	60	—	60*	—	ns
Address Hold Time		t _{AH}	Fig. 12	10	—	10	—	10	—	ns
Data Delay Time		t _{DDR}	Fig. 12	—	290	—	180	—	150	ns
Data Hold Time		t _{DHR}	Fig. 12	20	100	20	100	20	100	ns

* Characteristics will be improved.

2) WRITE

Item	Symbol	Test Condition	HD6321		HD63A21		HD63B21		Unit
			min	max	min	max	min	max	
Enable Cycle Time	t_{cycE}	Fig. 11	1000	—	666	—	500	—	ns
Enable Pulse Width, "High"	PW_{EH}	Fig. 11	450	—	280	—	220	—	ns
Enable Pulse Width, "Low"	PW_{EL}	Fig. 11	430	—	280	—	210	—	ns
Enable Pulse Rise and Fall Times	t_{Er}, t_{Ef}	Fig. 11	—	25	—	25	—	20	ns
Setup Time	t_{AS}	Fig. 13	80	—	60	—	60*	—	ns
Address Hold Time	Address, R/W—Enable	t_{AH}	10	—	10	—	10	—	ns
Data Setup Time	t_{DSW}	Fig. 13	165	—	80	—	60	—	ns
Data Hold Time	t_{DHW}	Fig. 13	10	—	10	—	10	—	ns

* Characteristics will be improved.

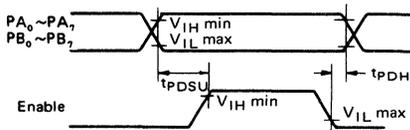
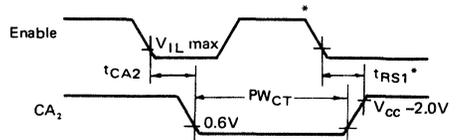


Figure 1 Peripheral Data Setup and Hold Times (Read Mode)



* Assumes part was deselected during the previous E pulse.

Figure 2 CA₂ Delay Time (Read Mode; CRA5=CRA3=1, CRA4=0)

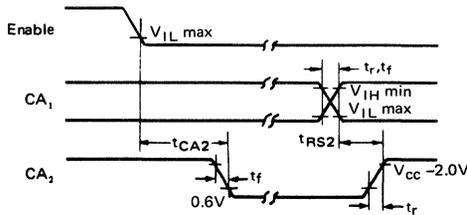


Figure 3 CA₂ Delay Time (Read Mode; CRA5=1, CRA3=CRA4=0)

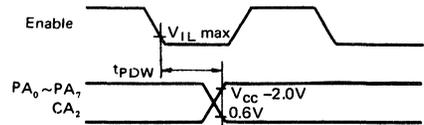
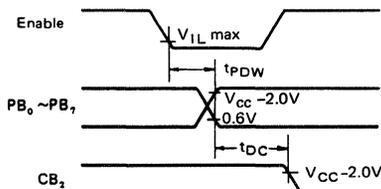
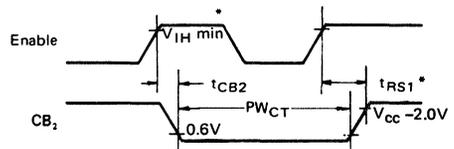


Figure 4 Peripheral Data Delay Times (Write Mode; CRA5=CRA3=1, CRA4=0)



(Note) CB₂ goes "Low" as a result of the positive transition of Enable.

Figure 5 Peripheral Data and CB₂ Delay Times (Write Mode; CRB5=CRB3=1, CRB4=0)



* Assumes part was deselected during the previous E pulse.

Figure 6 CB₂ Delay Time (Write Mode; CRB5=CRB3=1, CRB4=0)

■ PIA INTERFACE SIGNALS FOR MPU

The PIA interfaces to the HD6800 MPU with an eight-bit bi-directional data bus, three chip select lines, two register select lines, two interrupt request lines, read/write line, enable line and reset line. These signals, in conjunction with the HD6800 VMA output, permit the MPU to have complete control over the PIA. VMA should be utilized in conjunction with an MPU address line into a chip select of the PIA.

• Bi-Directional Data ($D_0 \sim D_7$)

The bi-directional data lines ($D_0 \sim D_7$) allow the transfer of data between the MPU and the PIA. The data bus output drivers are three-state devices that remain in the high-impedance (off) state except when the MPU performs a PIA read operation. The R/\bar{W} line is in the Read ("High") state when the PIA is selected for a Read operation.

• Enable (E)

The enable pulse, E, is the only timing signal that is supplied to the PIA. Timing of all other signals is referenced to the leading and trailing edges of the E pulse. This signal will normally be a derivative of the HMCS6800 System ϕ_2 Clock. This signal must be continuous clock pulse.

• Read/Write (R/W)

This signal is generated by the MPU to control the direction of data transfers on the Data Bus. A "Low" state on the PIA line enables the input buffers and data is transferred from the MPU to the PIA on the E signal if the device has been selected. A "High" on the R/\bar{W} line sets up the PIA for a transfer of data to the bus. The PIA output buffers are enabled when the proper address and the enable pulse E are present.

• Reset (\bar{RES})

The active "Low" \bar{RES} line is used to reset all register bits in the PIA to a logical zero "Low". This line can be used as a power-on reset and as a master reset during system operation.

• Chip Select (CS_0, CS_1 and \bar{CS}_2)

These three input signals are used to select the PIA. CS_0 and CS_1 must be "High" and \bar{CS}_2 must be "Low" for selection of the device. Data transfers are then performed under the control of the E and R/\bar{W} signals. The chip select lines must be stable for the duration of the E pulse. The device is deselected when any of the chip selects are in the inactive state.

• Register Select (RS_0 and RS_1)

The two register select lines are used to select the various registers inside the PIA. These two lines are used in conjunction with internal Control Registers to select a particular register that is to be written or read.

The register and chip select lines should be stable for the duration of the E pulse while in the read or write cycle.

• Interrupt Request (\bar{IRQA} and \bar{IRQB})

The active "Low" Interrupt Request lines (\bar{IRQA} and \bar{IRQB}) act to interrupt the MPU either directly or through interrupt priority circuitry. These lines are "open drain" (no load device on the chip). This permits all interrupt request lines to be tied together in a wire-OR configuration.

Each \bar{IRQ} line has two internal interrupt flag bits that can cause the \bar{IRQ} line to go "Low". Each flag bit is associated with a particular peripheral interrupt line. Also four interrupt enable bits are provided in the PIA which may be used to inhibit a particular interrupt from a peripheral device.

Servicing an interrupt by the MPU may be accomplished by a software routine that, on a prioritized basis, sequentially reads and tests the two control registers in each PIA for interrupt flag bits that are set.

The interrupt flags are cleared (zeroed) as a result of an MPU Read Peripheral Data Operation of the corresponding data register. After being cleared, the interrupt flag bit cannot be enabled to be set until the PIA is deselected during an E pulse. The E pulse is used to condition the interrupt control lines (CA_1, CA_2, CB_1, CB_2). When these lines are used as interrupt inputs at least one E pulse must occur from the inactive edge to the active edge of the interrupt input signal to condition the edge sense network. If the interrupt flag has been enabled and the edge sense circuit has been properly conditioned, the interrupt flag will be set on the next active transition of the interrupt input pin.

■ PIA PERIPHERAL INTERFACE LINES

Port A and Port B provide four interrupt control lines and two sets of 8-bit Bi-directional peripheral data bus for interfacing to input/output devices. Fig. 15 shows the block diagram of Port A and Port B. The output drivers of Port A and Port B consist of three-state drivers, allowing them to enter a High-impedance state when the peripheral data line is used as an input. Port A and Port B have the same output buffer. But the circuit configuration is slightly different and this makes the difference on data flow when MPU reads Port A and Port B in the case each Port is specified as output. As shown in Fig. 15, the output of the peripheral data A is transferred to internal data bus when used as output. On the other hand, in the case of Port B the contents of output register (ORB) is directly transferred to internal data bus through the multiplexor.

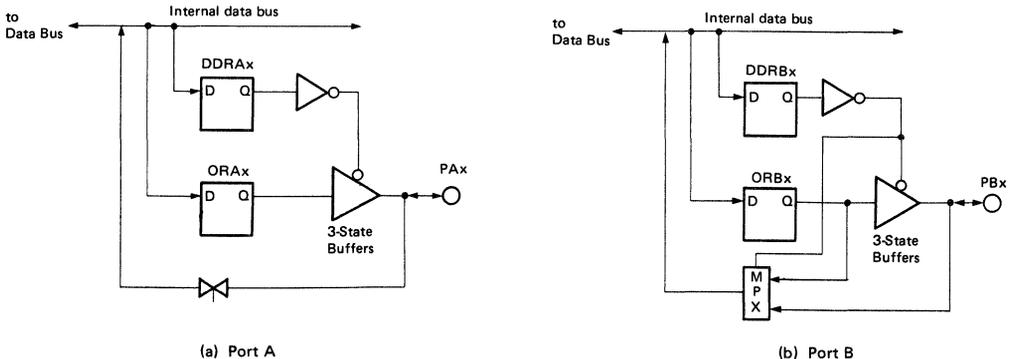


Figure 15 Block Diagram of Port A and Port B

• **Port A Peripheral Data (PA₀ ~ PA₇)**

Each of the peripheral data lines can be programmed to act as an input or output. This is accomplished by setting a "1" in the corresponding Data Direction Register bit for those lines which are to be outputs. A "0" in a bit of the Data Direction Register causes the corresponding peripheral data line to act as an input. During an MPU Read Peripheral Data Operation, the data on peripheral lines programmed to act as inputs appears directly on the corresponding MPU Data Bus lines.

The data in Output Register A will appear on the data lines that are programmed to be outputs. A logical "1" written into the register will cause a "High" on the corresponding data line while a "0" results in a "Low". Data in Output Register A may be read by an MPU "Read Peripheral Data A" operation when the corresponding lines are programmed as outputs.

• **Port B Peripheral Data (PB₀ ~ PB₇)**

Each of the Port B peripheral data bus can be programmed to act as an input or output like PA₀ ~ PA₇.

PB₀ ~ PB₇ are in High-impedance condition because they are three-state outputs just like PA₀ ~ PB₀ when the peripheral buses are used as inputs, when programmed as outputs, MPU read of Port B make it possible to read the output register regardless of PB₀ ~ PB₇ loads.

• **Interrupt Input (CA₁ and CB₁)**

Peripheral Input lines CA₁ and CB₁ are input only lines that set the interrupt flags of the control registers. The active transition for these signals is also programmed by the two control registers.

• **Peripheral Control (CA₂)**

The peripheral control line CA₂ can be programmed to act as an interrupt input or as a peripheral control output.

The function of this signal is programmed by the Control Register A. When used as an input, this signal is in High-impedance state

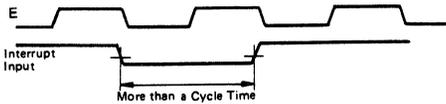
• **Peripheral Control (CB₂)**

Peripheral Control line CB₂ may also be programmed to act as an interrupt input or peripheral control output.

This line is programmed by Control Register B.

When used as an input, this signal is in High-impedance.

(NOTE) 1. Pulse width of interrupt inputs CA₁, CA₂, CB₁ and CB₂ shall be greater than a E cycle time. In the case that "High" time of E signal is not contained in Interrupt pulse, an interrupt flag may not be set.



■ **INTERNAL CONTROLS**

There are six locations within the PIA accessible to the MPU data bus: two Peripheral Registers, two Data Direction Registers, and two Control Registers. Selection of these locations is controlled by the RS₀ and RS₁ inputs together with bit 2 in the Control Register, as shown in Table 1.

Table 1 Internal Addressing

RS ₁	RS ₀	Control Register Bit		Location Selected
		CRA2	CRB2	
0	0	1	x	Peripheral Register A*
0	0	0	x	Data Direction Register A
0	1	x	x	Control Register A
1	0	x	1	Peripheral Register B*
1	0	x	0	Data Direction Register B
1	1	x	x	Control Register B

x = Don't Care

* Peripheral interface register is a generic term containing peripheral data bus and output register.

• **Initialization**

A "Low" reset line has the effect of zeroing all PIA registers. This will set PA₀ ~ PA₇, PB₀ ~ PB₇, CA₂ and CB₂ as inputs, and all interrupts disabled. The PIA must be configured during the restart program which follows the reset.

Details of possible configurations of the Data Direction and Control Register are as follows.

• **Data Direction Registers (DDRA and DDRB)**

The two Data Direction Registers allow the MPU to control the direction of data through each corresponding peripheral data line. A Data Direction Register bit set at "0" configures the corresponding peripheral data line as an input; a "1" results in an output.

• **Control Registers (CRA and CRB)**

The two Control Registers (CRA and CRB) allow the MPU to control the operation of the four peripheral control lines CA₁, CA₂, CB₁ and CB₂. In addition they allow the MPU to enable the interrupt lines and monitor the status of the interrupt flags. Bits 0 through 5 of the two registers may be written or read by the MPU when the proper chip select and register select signals are applied. Bits 6 and 7 of the two registers are read only and are modified by external interrupts occurring on control lines CA₁, CA₂, CB₁ or CB₂. The format of the control words is shown in Table 2.

Table 2 Control Word Format

	7	6	5	4	3	2	1	0
CRA	IRQA1	IRQA2	CA ₂ Control		DDRA Access	CA ₁ Control		
CRB	IRQB1	IRQB2	CB ₂ Control		DDRB Access	CB ₁ Control		

Data Direction Access Control Bit (CRA2 and CRB2)

Bit 2 in each Control register (CRA and CRB) allows selection of either a Peripheral Interface Register or the Data Direction Register when the proper register select signals are applied to RS₀ and RS₁.

Interrupt Flags (CRA6, CRA7, CRB6, and CRB7)

The four interrupt flag bits are set by active transitions of signals on the four Interrupt and Peripheral Control lines when those lines are programmed to be inputs. These bits cannot be set directly from the MPU Data Bus and are reset indirectly by a Read Peripheral Data Operation on the appropriate section.

Control of CA₁ and CB₁ Interrupt Lines (CRA0, CRB0, CRA1, and CRB1)

The two lowest order bits of the control registers are used to control the interrupt input lines CA₁ and CB₁. Bits CRA0 and

CRB0 are used to enable the MPU interrupt signals \overline{IRQA} and \overline{IRQB} , respectively. Bits CRA1 and CRB1 determine the active transition of the interrupt input signals CA₁ and CB₁ (Table 3). **Control of CA₂ and CB₂ Peripheral Control Lines (CRA3, CRA4, CRA5, CRB3, CRB4, and CRB5)**

Bits 3, 4 and 5 of the two control registers are used to control the CA₂ and CB₂ Peripheral Control lines. These bits determine if the control lines will be an interrupt input or an output control signal. If bit CRA5 (CRB5) is "0" CA₂ (CB₂) is an interrupt input line similar to CA₁ (CB₁) (Table 4). When CRA5 (CRB5) is "1", CA₂ (CB₂) becomes an output signal that may be used to control peripheral data transfers. When in the output mode, CA₂ and CB₂ have slightly different characteristics (Table 5 and 6).

Table 3 Control of Interrupt Inputs CA₁ and CB₁

CRA1 (CRB1)	CRA0 (CRB0)	Interrupt Input CA ₁ (CB ₁)	Interrupt Flag CRA7 (CRB7)	MPU Interrupt Request \overline{IRQA} (\overline{IRQB})
0	0	↓ Active	Set "1" on ↓ of CA ₁ (CB ₁)	Disabled – \overline{IRQ} remains "High"
0	1	↓ Active	Set "1" on ↓ of CA ₁ (CB ₁)	Goes "Low" when the interrupt flag bit CRA7 (CRB7) goes "1"
1	0	↑ Active	Set "1" on ↑ of CA ₁ (CB ₁)	Disabled – \overline{IRQ} remains "High"
1	1	↑ Active	Set "1" on ↑ of CA ₁ (CB ₁)	Goes "Low" when the interrupt flag bit CRA7 (CRB7) goes "1"

- (Notes)
1. ↑ indicates positive transition ("Low" to "High")
 2. ↓ indicates negative transition ("High" to "Low")
 3. The interrupt flag bit CRA7 is cleared by an MPU Read of the A Peripheral Register and CRB7 is cleared by an MPU Read of the B Peripheral Register.
 4. If CRA0 (CRB0) is "0" when an interrupt occurs (Interrupt disabled) and is later brought "1", \overline{IRQA} (\overline{IRQB}) occurs after CRA0 (CRB0) is written to a "1".

Table 4 Control of CA₂ and CB₂ as Interrupt Inputs – CRA5 (CRB5) is "0"

CRA5 (CRB5)	CRA4 (CRB4)	CRA3 (CRB3)	Interrupt Input CA ₂ (CB ₂)	Interrupt Flag CRA6 (CRB6)	MPU Interrupt Request \overline{IRQA} (\overline{IRQB})
0	0	0	↓ Active	Set "1" on ↓ of CA ₂ (CB ₂)	Disabled – \overline{IRQ} remains "High"
0	0	1	↓ Active	Set "1" on ↓ of CA ₂ (CB ₂)	Goes "Low" when the interrupt flag bit CRA6 (CRB6) goes "1"
0	1	0	↑ Active	Set "1" on ↑ of CA ₂ (CB ₂)	Disabled – \overline{IRQ} remains "High"
0	1	1	↑ Active	Set "1" on ↑ of CA ₂ (CB ₂)	Goes "Low" when the interrupt flag bit CRA6 (CRB6) goes "1"

- (Notes)
1. ↑ indicates positive transition ("Low" to "High")
 2. ↓ indicates negative transition ("High" to "Low")
 3. The interrupt flag bit CRA6 is cleared by an MPU Read of the A Peripheral Register and CRB6 is cleared by an MPU Read of the B Peripheral Register.
 4. If CRA3 (CRB3) is "0" when an interrupt occurs (Interrupt disabled) and is later brought "1", \overline{IRQA} (\overline{IRQB}) occurs after CRA3 (CRB3) is written to a "1".

Table 5 Control of CB₂ as an Output – CRB5 is "1"

CRB5	CRB4	CRB3	CB ₂	
			Cleared	Set
1	0	0	"Low" on the positive transition of the first E pulse after MPU Write "B" Data Register operation.	"High" when the interrupt flag bit CRB7 is set by an active transition of the CB ₁ signal. (See Figure 16)
1	0	1	"Low" on the positive transition of the first E pulse after an MPU Write "B" Data Register operation.	"High" on the positive edge of the first "E" pulse following an "E" pulse which occurred while the part was deselected. (See Figure 16)
1	1	0	"Low" (The content of CRB3 is output on CB ₂)	
1	1	1	"High" (The content of CRB3 is output on CB ₂)	

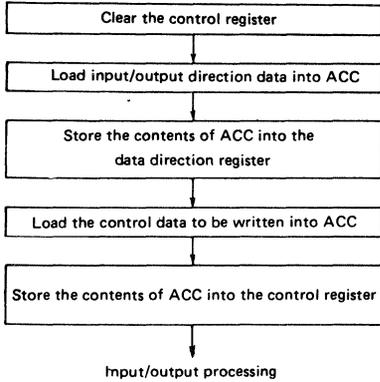
Table 6 Control of CA₂ as an Output – CRA5 is "1"

CRA5	CRA4	CRA3	CA ₂	
			Cleared	Set
1	0	0	"Low" on negative transition of E after an MPU Read "A" Data Operation.	"High" when the interrupt flag bit CRA7 is set by an active transition of the CA ₁ signal. (See Figure 16)
1	0	1	"Low" on negative transition of E after an MPU Read "A" Data operation.	"High" on the negative edge of the first "E" pulse which occurs during a deselect. (See Figure 16)
1	1	0	"Low" (The content of CRA3 is output on CA ₂)	
1	1	1	"High" (The content of CRA3 is output on CA ₂)	

■ PIA OPERATION

● Initialization

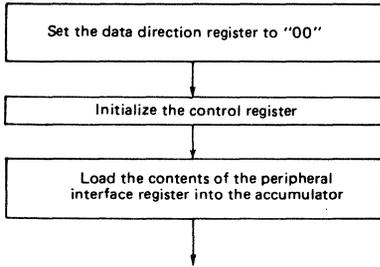
When the external reset input \overline{RES} goes "Low", all internal registers are cleared to "0". Peripheral data port ($PA_0 \sim PA_7$, $PB_0 \sim PB_7$) is defined to be input and control lines (CA_1, CA_2, CB_1 and CB_2) are defined to be the interrupt input lines. PIA is also initialized by software sequence as follows.



- Program the data direction register access bit of the control register to "0" to allow to access the data direction register.

- The data of the control line function is set into the accumulator, of which Data Direction Register Access Bit shall be programmed to "1".
- Transfer the control data from the accumulator into the control register.

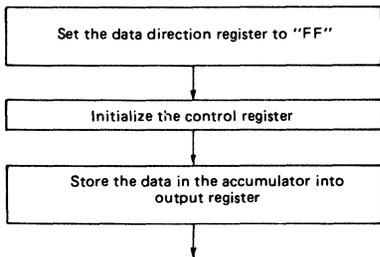
● Read/Write Operation Not Using Control Lines
<Read Operation>



CLR CRA
 CLR DDRA
 LDAA #\$04
 STAA CRA
 LDAA PIRA

- Clear the DDRA access bit of the control register to "0".
- Clear all bits of the data direction register.
- Set DDRA access bit of the control register to "1" to allow to access the peripheral interface register.

<Write Operation>



CLR CRA
 LDAA #\$FF
 STAA DDRB
 LDAA #\$04
 STAA CRB
 LDAA DATA
 STAA PIRB

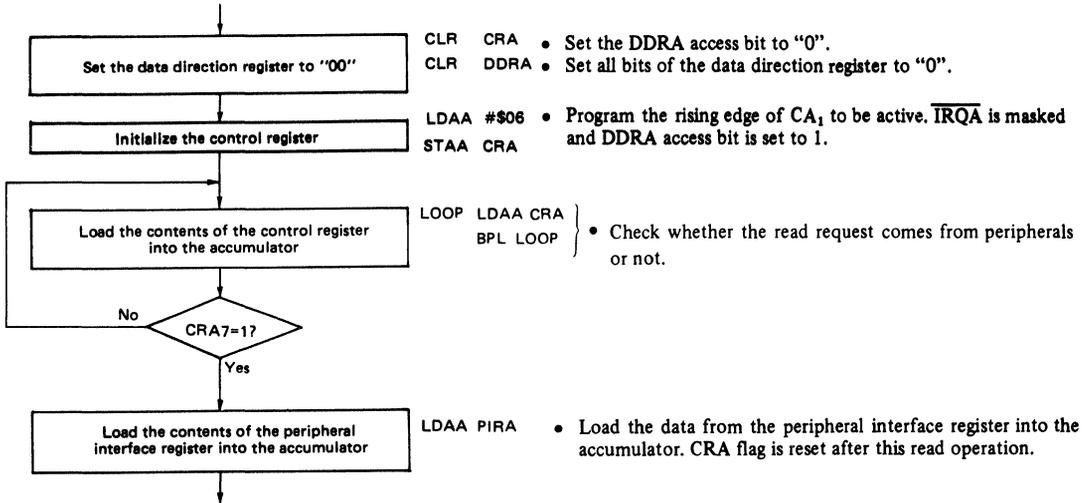
- Set DDRB access bit of the control register to "0".
- Set all bits of the data direction register to "FF".
- Set DDRB access bit of the control register to "1" to allow to access the peripheral interface register.
- Write the data into the peripheral interface register.

• **Read/Write Operating Using Control Lines**

Read/write request from peripherals shall be put into the control lines as an interrupt signal, and then MPU reads or writes after detecting interrupt request.

< Read >

The following case is that Port A is used and that the rising edge of CA₁ indicates the request for read from peripherals.

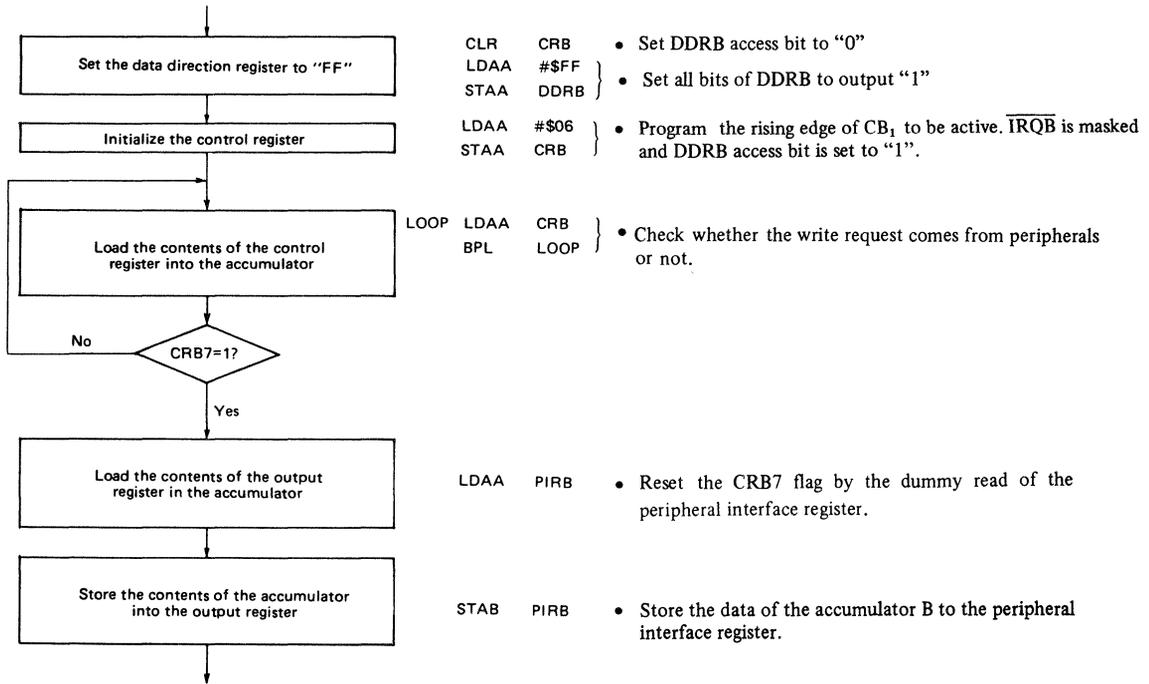


To read the peripheral data, the data is directly transferred to the data buses D₀~D₇ through PA₀~PA₇ or PB₀~PB₇ and they are not latched in the PIA. If necessary, the data should be held in the external latch until MPU completes reading it.

When initializing the control register, interrupt flag bit (CRA7, CRA6, CRB7, CRB6) cannot be written from MPU. If necessary the interrupt flag must be reset by dummy read of Peripheral Register A and B.

< Write >

Write operation using the interrupt signal is as follows. In this case, B port is used and interrupt request is input to CB₁. And the IRQ flag is set at the rising edge of CB₁.



Interrupt request flag bits (CRA7, CRA6, CRB7 and CRB6) cannot be written and they cannot be also reset by write operation to the peripheral interface register. So dummy read of peripheral interface register is needed to reset the flags.

To accept the next interrupt, it is essential to reset indirectly the interrupt flag by dummy read of peripheral interface register.

Software poling method mentioned above requires MPU to continuously monitor the control register to detect the read/write request from peripherals. So other programs cannot run at the same time. To avoid this problem, hardware interrupt may be used. The MPU is interrupted by \overline{IRQA} or \overline{IRQB} when the read/write request is occurred from peripherals and then MPU analyzes cause of the interrupt request during interrupt processing.

• **Handshake Mode**

The functions of CRA and CRB are similar but not identical in the hand-shake modes. Port A is used for read hand-shake operation and Port B is used for write hand-shake mode.

CA₁ and CB₁ are used for interrupt input requests and CA₂ and CB₂ are control outputs (answer) in hand-shake mode.

Fig. 16, Fig. 17 and Fig. 18 show the timing of hand-shake mode.

< Read Hand-shake Mode >

CRA5="1", CRA4="0" and CRA3="0"

- ① A peripheral device puts the 8-bit data on the peripheral data lines after the control output CA₂ goes "Low"
- ② The peripheral requests MPU to read the data by using CA₁ input.

- ③ CRA7 flag is set and CA₂ becomes "High" (CA₂ automatically becomes "High" by the interrupt CA₁). This indicates the peripheral to maintain the current data and not to transfer the next data.
- ④ MPU accepts the read request by \overline{IRQA} hardware interrupt or CRA read. Then MPU reads the peripheral register A.
- ⑤ CA₂ goes "Low" on the following edge of read Enable pulse. This informs that the peripheral can set the next data to port A.

<Write Hand-shake>

CRB5 = "1", CRB4 = "0" and CRB3 = "0"

- ① A peripheral device requests MPU to write the data by using CB₁ input. CB₂ output remains "High" until MPU write data to the peripheral interface register.
- ② CRB7 flag is set and MPU accepts the write request.
- ③ MPU reads the peripheral interface register to reset CRB7 (dummy read).
- ④ Then MPU write data to the peripheral interface register. The data is output to port B through the output register.
- ⑤ CB₂ automatically becomes "Low" to tell the peripheral that new data is on port B.
- ⑥ The peripheral read the data on Port B peripheral data lines and set CB₁ to "Low" to tell MPU that the data on the peripheral data lines has been taken and that next data can be written to the peripheral interface register.

<Pulse mode>

CRA5 = "1", CRA4 = "0" and CRA3 = "1"

CRB5 = "1", CRB4 = "0" and CRB3 = "1"

This mode is shown in Figure 16, Figure 19 and Figure 20.

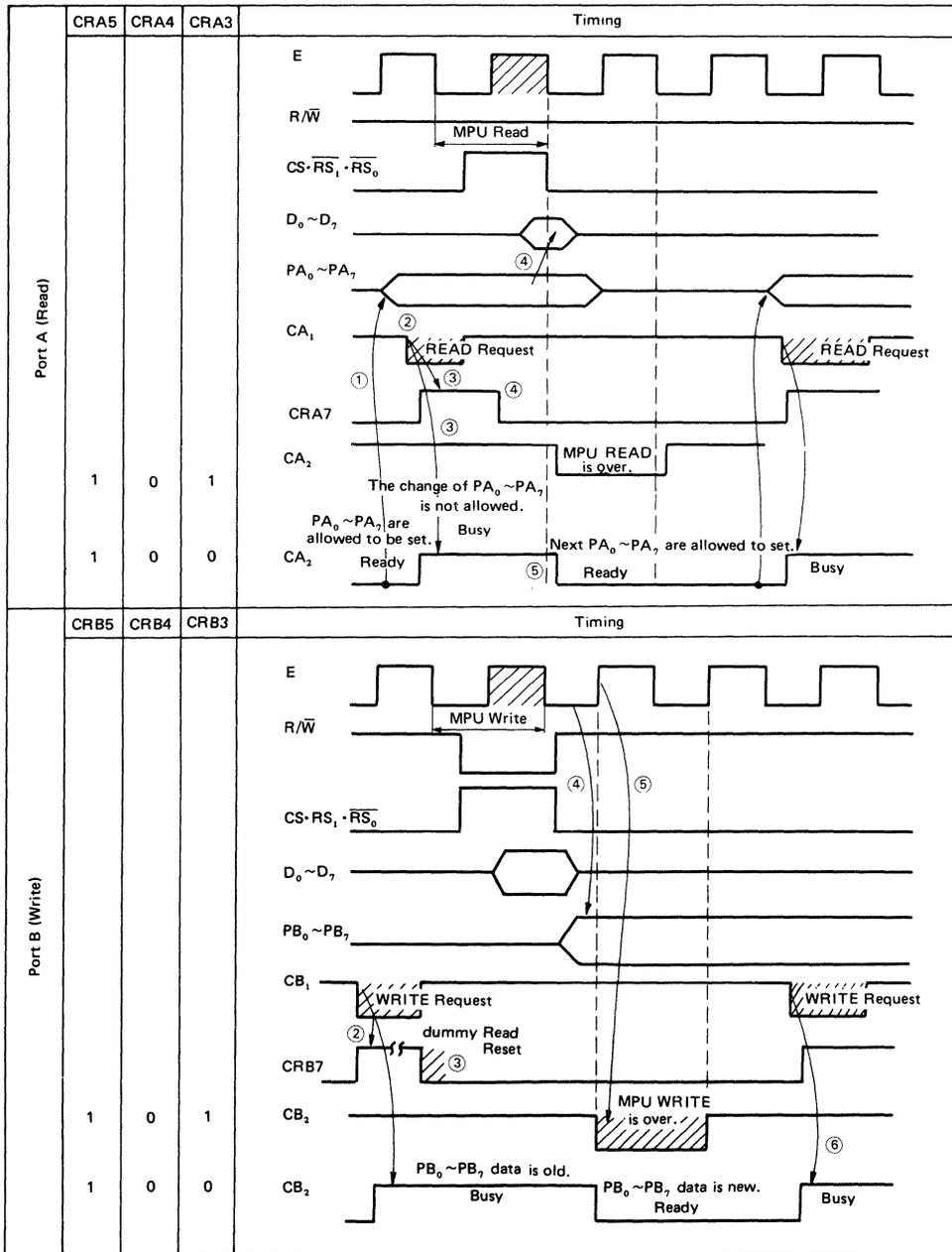


Figure 16 Timing of Hand-shake Mode and Pulse Mode

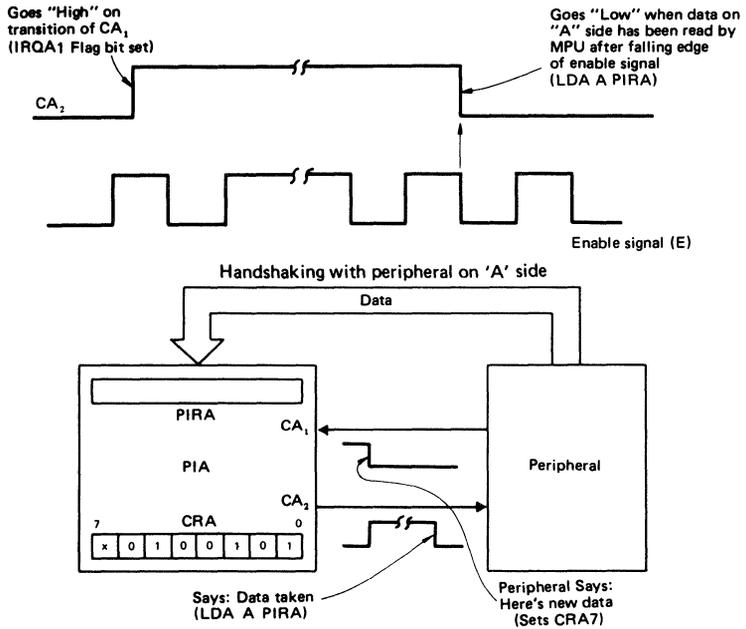


Figure 17 Bits 5, 4, 3 of CRA = 100 (Hand-shake Mode)

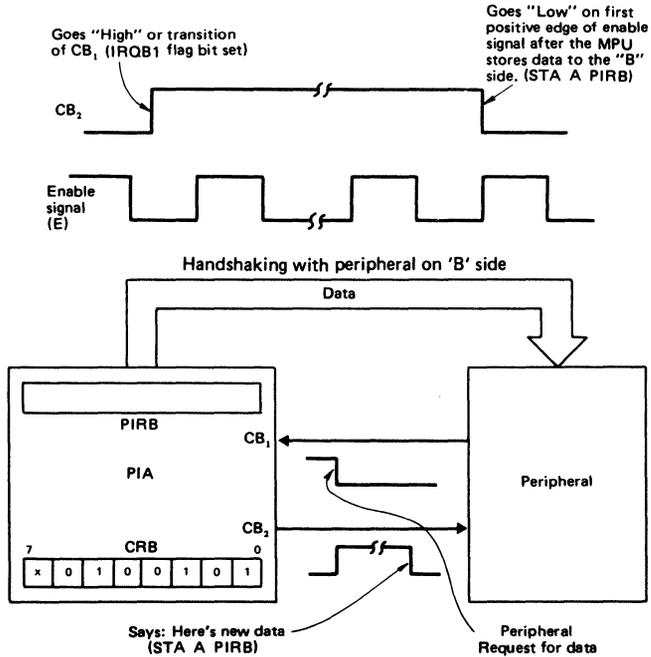


Figure 18 Bits 5, 4, 3 of CRB = 100 (Hand-shake Mode)

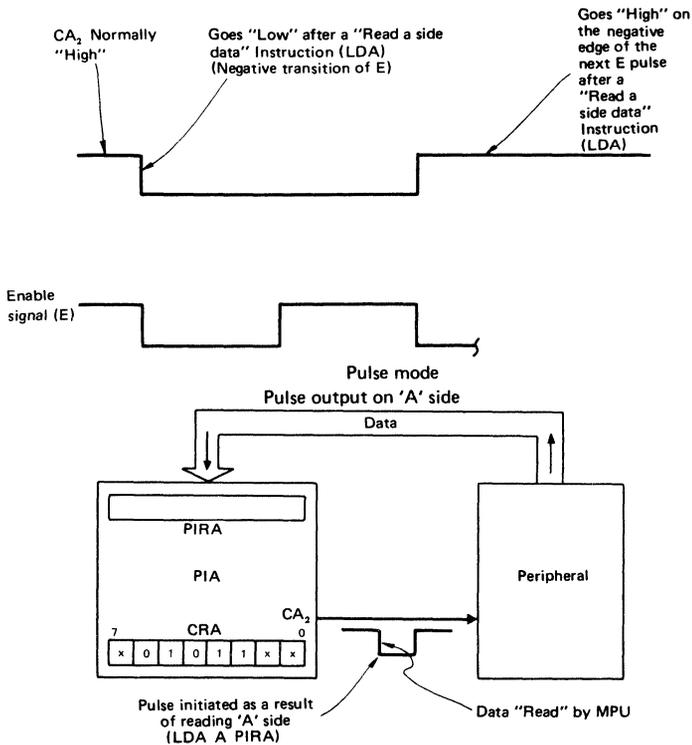


Figure 19 Bits 5, 4, 3 of CRA = 101 (Pulse Mode)

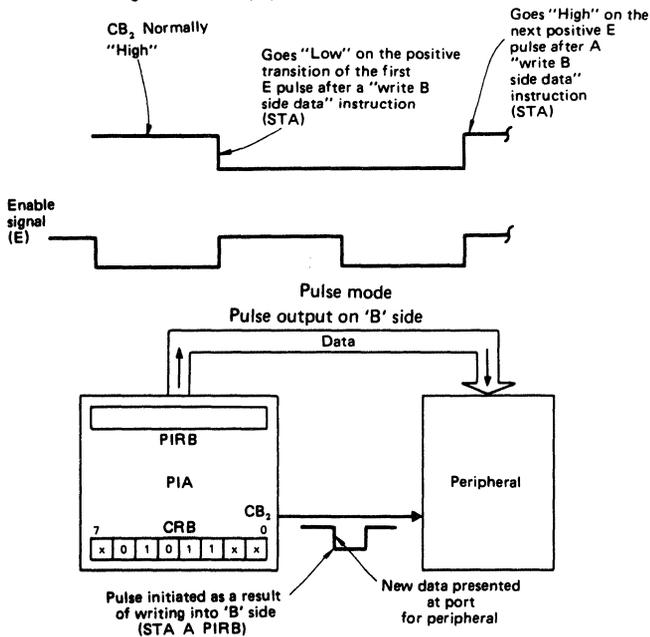


Figure 20 Bits 5, 4, 3 of CRB=101 (Pulse Mode)

■ **SUMMARY OF CONTROL REGISTERS CRA AND CRB**

Control registers CRA and CRB have total control of CA₁, CA₂, CB₁, and CB₂ lines. The status of eight bits of the control registers may be read into the MPU. However, the MPU can only write into Bit 0 through Bit 5 (6 bits), since Bit 6 and Bit 7 are set only by CA₁, CA₂, CB₁, or CB₂.

● **Addressing PIAs**

Before addressing PIAs, the data direction (DDR) must first be loaded with the bit pattern that defines how each line is to function, i.e., as an input or an output. A logic "1" in the data direction register defines the corresponding line as an output while a logic "0" defines the corresponding line as an input. Since the DDR and the peripheral interface register have the same address, the control register bit 2 determines which register is being addressed. If Bit 2 in the control register is a logic "0", then the DDR is addressed. If Bit 2 in the control register is a logic "1", the peripheral interface register is addressed. Therefore, it is essential that the DDR be loaded first before setting Bit 2 of the control register.

<Example>

Given a PIA with an address of 4004, 4005, 4006, and 4007. 4004 is the address of the A side peripheral interface register. 4005 is the address of the A side control register. 4006 is the address of the B side peripheral interface register. 4007 is the address of the B side control register. On the A side, Bits 0, 1, 2, and 3 will be defined as inputs, while Bits 4, 5, 6, and 7 will be used as outputs. On the B side, all lines will be used as outputs.

PIA1AD = 4004 (DDRA, PIRA)
 PIA1AC = 4005 (CRA)
 PIA1BD = 4006 (DDRB, PIRB)
 PIA1BC = 4007 (CRB)

1. LDA A #%11110000 (4 outputs, 4 inputs)
2. STA A PIA1AD (Loads A DDR)
3. LDA A #%11111111 (All outputs)
4. STA A PIA1BD (Loads B DDR)
5. LDA A #%00000100 (Sets Bit 2)
6. STA A PIA1AC (Bit 2 set in A control register)
7. STA A PIA1BC (Bit 2 set in B control register)

Statement 2 addresses the DDR, since the control register (Bit 2) has not been loaded. Statements 6 and 7 load the control registers with Bit 2 set, so addressing PIA1AD or PIA1BD accesses the peripheral interface register.

● **PIA Programming Via The Index Register**

The program shown in the previous section can be accomplished using the Index Register.

1. LDX # \$F004
2. STX PIA1AD \$F0→PIA1AD; \$04→PIA1AC
3. LDX # \$FF04
4. STX PIA1BD \$FF→PIA1BD; \$04→PIA1BC

Using the index register in this example has saved six bytes of program memory as compared to the program shown in the previous section.

● **Active Low Outputs**

When all the outputs of given PIA port are to be active "Low" (True ≤ 0.4 volts), the following procedure should be used.

- a) Set Bit 2 in the control register.
- b) Store all 1s (\$FF) in the peripheral interface register.
- c) Clear Bit 2 in the control register.
- d) Store all 1s (\$FF) in the data direction register.
- e) Store control word (Bit 2 = 1) in control register.

<Example>

The B side of PIA1 is set up to have all active low outputs. CB₁ and CB₂ are set up to allow interrupts in the HAND-SHAKE MODE and CB₁ will respond to positive edges ("Low"-to-"High" transitions). Assume reset conditions. Addresses are set up and equated to the same labels as previous example.

1. LDA A #4
2. STA A PIA1BC Set Bit 2 in PIA1BC (control register)
3. LDA B # \$FF
4. STA B PIA1BD All 1s in peripheral interface register
5. CLR PIA1BC Clear Bit 2
6. STA B PIA1BD All 1s in data direction register
7. LDA A # \$27
8. STA A PIA1BC 00100111 → control register

The above procedure is required in order to avoid outputs going "Low", to the active "Low" TRUE STATE, when all 1s are stored to the data direction register as would be the case if the normal configuration procedure were followed.

● **Interchanging RS₀ And RS₁**

Some system applications may require movement of 16 bits of data to or from the "outside world" via two PIA ports (A side + B side). When this is the case it is an advantage to interconnect RS₁ and RS₀ as follows.

RS₀ to A1 (Address Line A1)
 RS₁ to A0 (Address Line A0)

This will place the peripheral interface registers and control registers side by side in the memory map as follows.

Table	Example Address	
PIA1AD	\$4004	(DDRA, PIRA)
PIA1BD	\$4005	(DDRB, PIRB)
PIA1AC	\$4006	(CRA)
PIA1BC	\$4007	(CRB)

The index register or stackpointer may be used to move the 16-bit data in two 8-bit bytes with one instruction. As an example:

LDX PIA1AD PIA1AD → IXH; PIA1BD → IXL

● **PIA - After Reset**

When the RES (Reset Line) has been held "Low" for a minimum of one microsecond, all registers in the PIA will be cleared.

Because of the reset conditions, the PIA has been defined as

follows.

1. All I/O lines to the "outside world" have been defined as inputs.
2. CA₁, CA₂, CB₁, and CB₂ have been defined as interrupt input lines that are negative edge sensitive.
3. All the interrupts on the control lines are masked. Setting of interrupt flag bits will not cause \overline{IRQA} or \overline{IRQB} to go "Low".

■ SUMMARY OF CA₂-CB₂ PROGRAMMING

Bits 5, 4, and 3 of the control registers are used to program the operation of CA₂-CB₂.

	b5	b4	b3	
CA ₂ -CB ₂ Input Mode	0	0(-)	0 (Mask)	CA ₂ -CB ₂ Input Mode b4 = Edge (0 = -, 1 = +) b3 = Mask (0 = Mask, 1 = Allow)
	0	0(-)	1 (Allow)	
	0	1(+)	0 (Mask)	
	0	1(+)	1 (Allow)	

CA ₂ -CB ₂ Output Mode	1	0	0 - Handshake Mode
	1	0	1 - Pulse Mode
	1	1	} b3 Following Mode
	1	1	

■ SUMMARY OF CA₁-CB₁ PROGRAMMING

Bits 1 and 0 of the respective control registers are used to program the interrupt input control lines CA₁ and CB₁.

b1	b0	
0	0	b1 = Edge (0 = -, 1 = +)
0	1	b0 = Mask (0 = Mask, 1 = Allow)
1	0	
1	1	

Note that this is the same logic as Bits 4 and 3 for CA₂-CB₂ when CA₂-CB₂ are programmed as inputs.

I/O As Follow:

Control Lines:

CA₁ - Positive Edge, Allow Interrupt

CA₂ - Pulse Mode

CB₁ - Negative Edge, Mask Interrupt

CB₂ - Hand Shake Mode

Assume Reset Condition

PIA1AD

PIA1AC

PIA1BD

PIA1BC

PIA Configuration Solution

LDA A #\$BC 10111100

STA A PIA1AD I/O to DDRA

LDA A #\$FF 1111 1111

STA A PIA1BD I/O to DDRB

LDA A #\$2F 0010 1111

STA A PIA1AC To "A" Control

LDA A #\$24 0010 0100

STA A PIA1BC To "B" Control

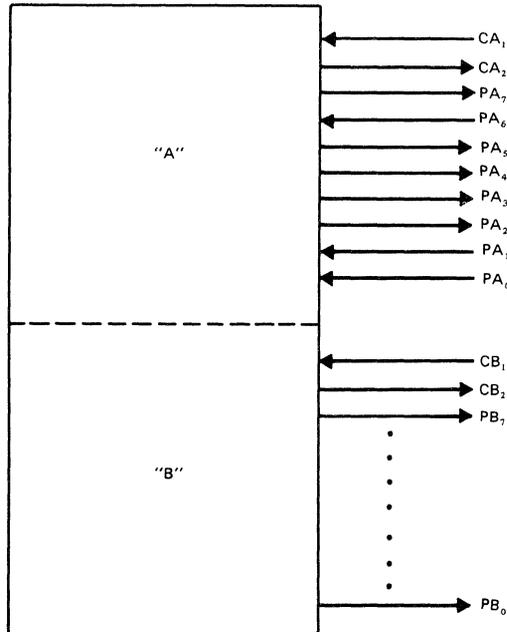
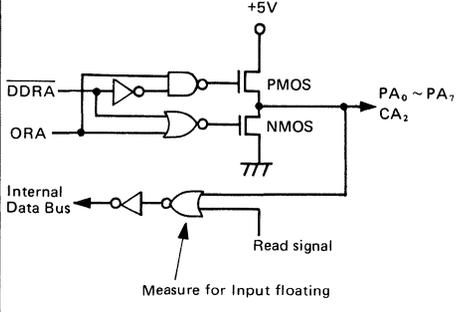
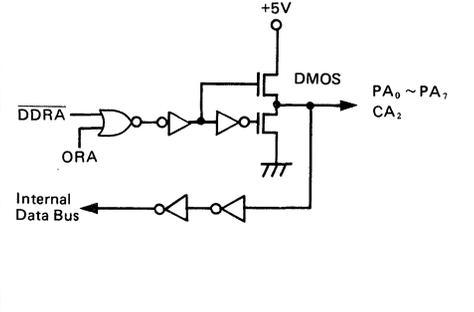
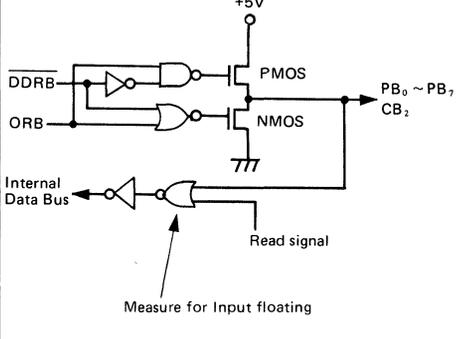
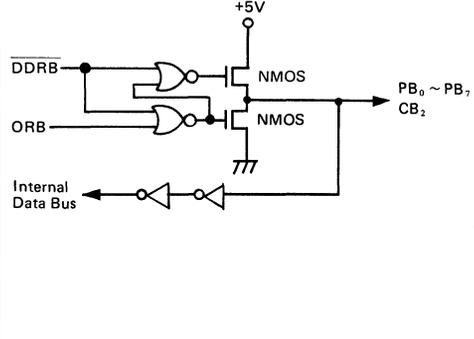


Figure 21 PIA Configuration Problem

■ NOTE FOR USE

Compatibility with NMOS PIA (HD6821)

Table 7 Comparison CMOS PIA (HD6321) with NMOS PIA (HD6821)

Item	CMOS PIA (HD6321)	NMOS PIA (HD6821)
<p>Port A Output Buffer</p>	<p>Three-state output</p> 	<p>Pull-up output</p> 
<p>Port B Output Buffer</p>	<p>Three-state output</p> 	<p>Three-state output</p> 

There is no difference between CMOS PIA and NMOS PIA in pin arrangement.

HD6840, HD68A40, HD68B40

PTM (Programmable Timer Module)

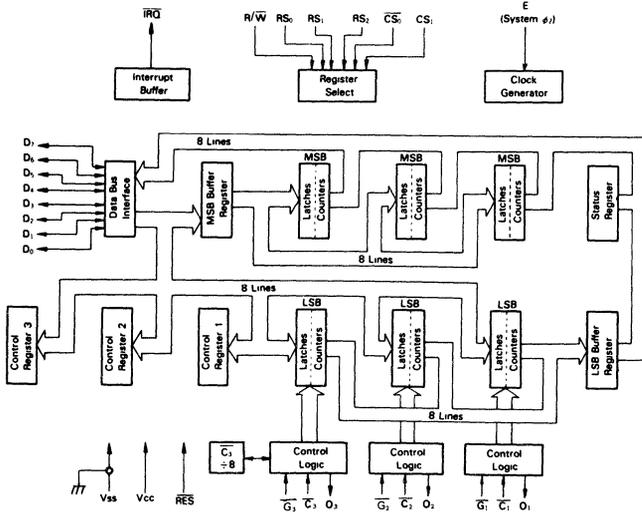
The HD6840 is a programmable subsystem component of the HMCS6800 family designed to provide variable system time intervals.

The HD6840 has three 16-bit binary counters, three corresponding control registers and a status register. These counters are under software control and may be used to cause system interrupts and/or generate output signals. The HD6840 may be utilized for such tasks as frequency measurements, event counting, interval measuring and similar tasks. The device may be used for square wave generation, gated delay signals, single pulses of controlled duration, and pulse width modulation as well as system interrupts.

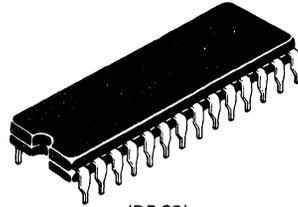
■ FEATURES

- Operates from a Single 5 Volts Power Supply
- Fully TTL Compatible
- Single System Clock Required (E)
- Selectable Prescaler on Timer 3 Capable of 4 MHz for the HD6840, 6 MHz for the HD68A40 and 8 MHz for the HD68B40
- Programmable Interrupts (\overline{IRQ}) Output to MPU
- Readable Down Counter Indicates Counts to Go until Time-Out
- Selectable Gating for Frequency or Pulse-Width Comparison
- RES Input
- Three Asynchronous External Clock and Gate/Trigger Inputs Internally Synchronized
- Three Maskable Outputs
- Compatible with MC6840, MC68A40 and MC68B40

■ BLOCK DIAGRAM

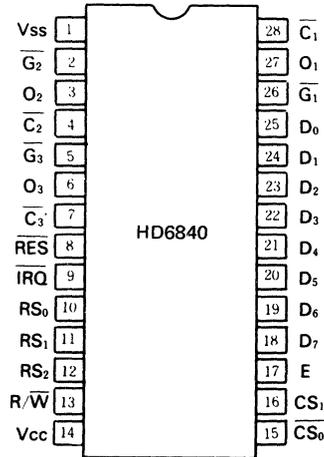


HD6840P, HD68A40P, HD68B40P



(DP-28)

■ PIN ARRANGEMENT



(Top View)

■ ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Value	Unit
Supply Voltage	V_{CC}^*	-0.3~+7.0	V
Input Voltage	V_{in}^*	-0.3~+7.0	V
Operating Temperature	T_{opr}	-20~+75	°C
Storage Temperature	T_{stg}	-55~+150	°C

* With respect to V_{SS} (SYSTEM GND)

[NOTE] Permanent LSI damage may occur if maximum ratings are exceeded. Normal operation should be under recommended operating conditions. If these conditions are exceeded, it could affect reliability of LSI.

■ RECOMMENDED OPERATING CONDITIONS

Item	Symbol	min	typ	max	Unit
Supply Voltage	V_{CC}^*	4.75	5.0	5.25	V
Input Voltage	V_{IL}^*	-0.3	-	0.8	V
	V_{IH}^*	2.2	-	V_{CC}	V
Operating Temperature	T_{opr}	-20	25	75	°C

* With respect to V_{SS} (SYSTEM GND)

■ ELECTRICAL CHARACTERISTICS

● DC CHARACTERISTICS ($V_{CC} = 5V \pm 5\%$, $V_{SS} = 0V$, $T_a = -20 \sim +75^\circ C$, unless otherwise noted.)

Item	Symbol	Test Condition	min	typ*	max	Unit	
Input "High" Voltage	V_{IH}		2.2	-	V_{CC}	V	
Input "Low" Voltage	V_{IL}		-0.3	-	0.8	V	
Input Leakage Current	I_{in}	$V_{in} = 0 \sim 5.25V$ (Except $D_0 \sim D_7$)	-2.5	-	2.5	μA	
Three-State Input Current (off-state)	I_{TSI}	$V_{in} = 0.4 \sim 2.4V$, $V_{CC} = 5.25V$ ($D_0 \sim D_7$)	-10	-	10	μA	
Output "High" Voltage	V_{OH}	$I_{LOAD} = -205 \mu A$ ($D_0 \sim D_7$)	2.4	-	-	V	
		$I_{LOAD} = -200 \mu A$ (Other Outputs)					
Output "Low" Voltage	V_{OL}	$I_{LOAD} = 1.6 mA$ ($D_0 \sim D_7$)	-	-	0.4	V	
		$I_{LOAD} = 3.2 mA$ ($O_1 \sim O_3, \overline{IRQ}$)					
Output Leakage Current (off-state)	I_{LOH}	$V_{OH} = 2.4V$ (\overline{IRQ})	-	-	10	μA	
Power Dissipation	P_D		-	330	550	mW	
Input Capacitance	C_{in}	$V_{in} = 0V$, $T_a = 25^\circ C$, $f = 1 MHz$	$D_0 \sim D_7$	-	-	12.5	μF
			Other Input	-	-	7.5	
Output Capacitance	C_{out}	$V_{in} = 0V$, $T_a = 25^\circ C$, $f = 1 MHz$	\overline{IRQ}	-	-	5.0	μF
			O_1, O_2, O_3	-	-	10	

* $T_a = 25^\circ C$, $V_{CC} = 5.0V$

● AC CHARACTERISTICS (V_{CC} = 5V ± 5%, V_{SS} = 0V, T_a = -20 ~ +75°C, unless otherwise noted.)

1. MPU READ TIMING

Item	Symbol	Test Condition	HD6840			HD68A40			HD68B40			Unit
			min	typ	max	min	typ	max	min	typ	max	
Enable Cycle Time	t _{cycE}	Fig. 1	1.0	—	10	0.666	—	10	0.5	—	10	μs
Enable "High" Pulse Width	PW _{EH}		0.45	—	4.5	0.280	—	4.5	0.22	—	4.5	μs
Enable "Low" Pulse Width	PW _{EL}		0.43	—	—	0.280	—	—	0.21	—	—	μs
Enable Rise and Fall Time	t _{Er} , t _{Ef}		—	—	25	—	—	25	—	—	25	ns
Address Set Up Time	t _{AS}		140	—	—	140	—	—	70	—	—	ns
Data Delay Time	t _{DDR}		—	—	320	—	—	220	—	—	180	ns
Data Hold Time	t _H		10	—	—	10	—	—	10	—	—	ns
Address Hold Time	t _{AH}		10	—	—	10	—	—	10	—	—	ns
Data Access Time	t _{ACC}		—	—	480	—	—	360	—	—	250	ns

2. MPU WRITE TIMING

Item	Symbol	Test Condition	HD6840			HD68A40			HD68B40			Unit
			min	typ	max	min	typ	max	min	typ	max	
Enable Cycle Time	t _{cycE}	Fig. 2	1.0	—	10	0.666	—	10	0.5	—	10	μs
Enable "High" Pulse Width	PW _{EH}		0.45	—	4.5	0.280	—	4.5	0.22	—	4.5	μs
Enable "Low" Pulse Width	PW _{EL}		0.43	—	—	0.280	—	—	0.21	—	—	μs
Enable Rise and Fall Time	t _{Er} , t _{Ef}		—	—	25	—	—	25	—	—	25	ns
Address Set Up Time	t _{AS}		140	—	—	140	—	—	70	—	—	ns
Data Set Up Time	t _{DSW}		195	—	—	80	—	—	60	—	—	ns
Data Hold Time	t _H		10	—	—	10	—	—	10	—	—	ns
Address Hold Time	t _{AH}		10	—	—	10	—	—	10	—	—	ns

3. TIMING OF PTM SIGNAL

Item	Symbol	Test Condition	HD6840		HD68A40		HD68B40		Unit			
			min	max	min	max	min	max				
Input Rise and Fall Times	C, G, RES	t _r , t _f	Fig. 3, Fig. 4		—	1.0*	—	0.666*	—	0.5*	μs	
Input "Low" Pulse Width	C, G, RES	PW _L	Fig. 3 (Asynchronous Mode)		t _{cycE} + t _{SU} + t _{HD}	—	t _{cycE} + t _{SU} + t _{HD}	—	t _{cycE} + t _{SU} + t _{HD}	—	ns	
Input "High" Pulse Width	C, G	PW _H	Fig. 4 (Asynchronous Mode)		t _{cycE} + t _{SU} + t _{HD}	—	t _{cycE} + t _{SU} + t _{HD}	—	t _{cycE} + t _{SU} + t _{HD}	—	ns	
Input Setup Time	C, G, RES	t _{SU}	Fig. 5 (Synchronous Mode)		200	—	120	—	75	—	ns	
	C ₃ (÷8 Pre-scaler Mode)		Fig. 5 (Synchronous Mode)		200	—	170	—	170	—		
Input Hold Time	C, G, RES	t _{HD}	Fig. 5 (Synchronous Mode)		50	—	50	—	50	—	ns	
	C ₃ (÷8 Pre-scaler Mode)		Fig. 5 (Synchronous Mode)		50	—	50	—	50	—		
Input Pulse Width	C ₃ (÷8 Pre-scaler Mode)	PW _L , PW _H	(Asynchronous Mode)		125	—	84	—	62.5	—	ns	
Output Delay Time	O ₁ ~ O ₃	TTL	t _{co}	Fig. 6	V _{OH} = 2.4V, Load B	—	700	—	460	—	340	ns
		MOS	t _{cm}		V _{OH} = 2.4V, Load D	—	450	—	450	—	340	ns
		CMOS	t _{cmos}		V _{OH} = 0.7 × V _{CC} , Load D	—	2.0	—	1.35	—	1.0	μs
Interrupt Release Time		t _{IR}	Fig. 7		—	1.2	—	0.9	—	0.7	μs	

* t_r, t_f ≤ t_{cycE}

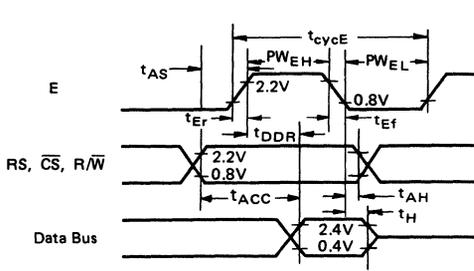


Figure 1 Bus Read Timing (Read Information from PTM)

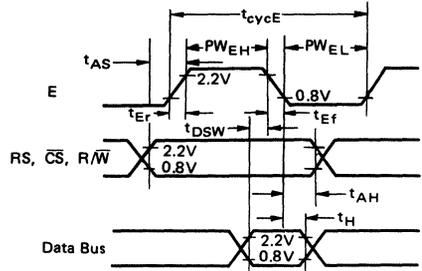


Figure 2 Bus Write Timing (Write Information into PTM)

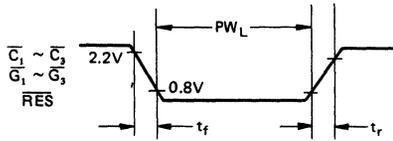


Figure 3 Input Pulse Width "Low"

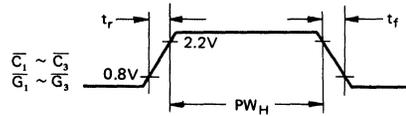


Figure 4 Input Pulse Width "High"

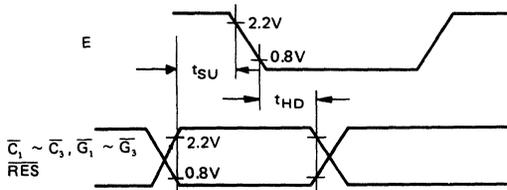


Figure 5 Input Setup and Hold Times

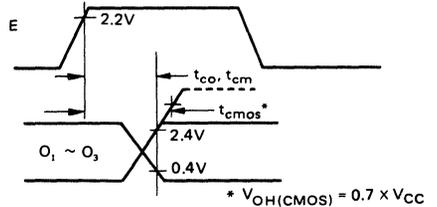


Figure 6 Output Delay

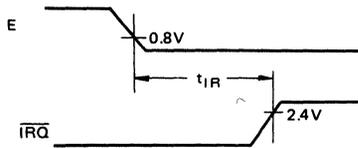


Figure 7 \overline{IRQ} Release Time

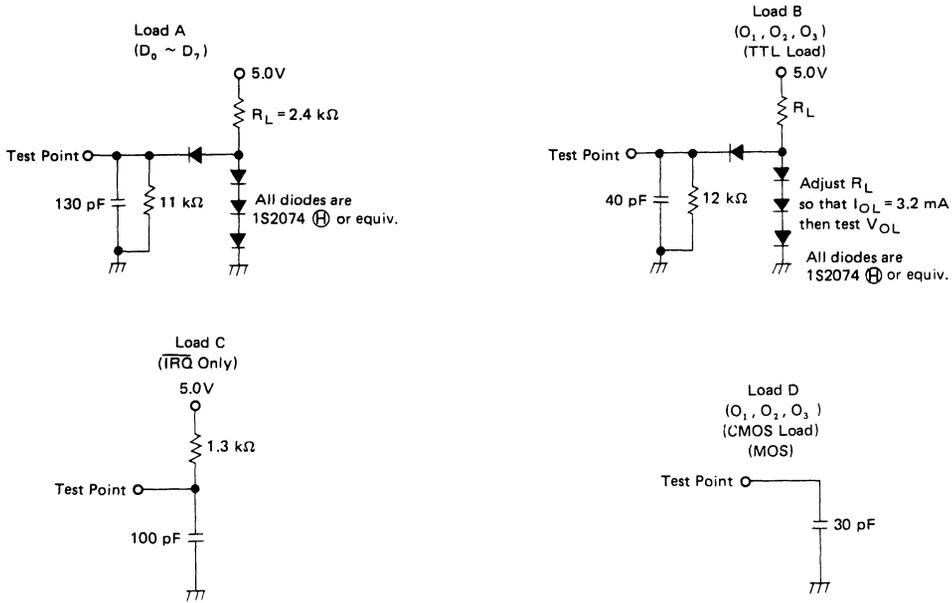


Figure 8 Test Loads

■ GENERAL DESCRIPTION

The HD6840 is part of the HMCS6800 microprocessor family and is fully bus compatible with HD6800 systems. The three timers in the HD6840 operate independently and in several distinct modes to fit a wide variety of measurement and synthesis applications.

The HD6840 is an integrated set of three distinct counter/timers. It consists of three 16-bit data latches, three 16-bit counters (clocked independently), and the comparison and enable circuitry necessary to implement various measurement and synthesis functions. In addition, it contains interrupt drivers to alert the processor that a particular function has been completed.

In a typical application, a timer will be loaded by first storing two bytes of data into an associated Counter Latch. This data is then transferred into the counter via a Counter initialization cycle. If the counter is enabled, the counter decrements on each subsequent clock period which may be an external clock, or Enable (E) until one of several predetermined conditions causes it to halt or recycle. The timers are thus programmable, cyclic in nature, controllable by external inputs or the MPU program, and accessible by the MPU at any time.

■ PTM INTERFACE SIGNALS FOR MPU

The Programmable Timer Module (PTM) interfaces to the HMCS6800 Bus with an eight-bit bidirectional data bus, two

Chip Select lines, a Read/Write line, an Enable (System ϕ_2) line, an Interrupt Request line, an external Reset line, and three Register Select lines. These signals, in conjunction with the HD6800 VMA output, permit the MPU to control the PTM. VMA should be utilized in conjunction with an MPU address line into a Chip Select of the PTM, when the HD6800, HD6802 are used.

● Bidirectional Data ($D_0 \sim D_7$)

The bidirectional data lines ($D_0 \sim D_7$) allow the transfer of data between the MPU and PTM. The data bus output drivers are three-state devices which remain in the high-impedance (off) state except when the MPU performs a PTM read operation (Read/Write and Enable lines "High" and PTM Chip Selects activated).

● Chip Select (\overline{CS}_0, CS_1)

These two signals are used to activate the Data Bus interface and allow transfer of data from the PTM. With $\overline{CS}_0 = \text{"Low"}$ and $CS_1 = \text{"High"}$, the device is selected and data transfer will occur.

● Read/Write (R/\overline{W})

This signal is generated by the MPU to control the direction of data transfer on the Data Bus. With the PTM selected, a "Low" state on the PTM R/\overline{W} line enables the input buffers and

data is transferred from the MPU to the PTM on the trailing edge of the Enable (System ϕ_2) signal. Alternately, (under the same conditions) R/\bar{W} = "High" and Enable "High" allows data in the PTM to be read by the MPU.

• **Enable (E)**

This signal synchronizes data transfer between the MPU and the PTM. It also performs an equivalent synchronization function on the external clock, reset, and gate inputs of the PTM.

• **Interrupt Request (\overline{IRQ})**

The active "Low" Interrupt Request signal is normally tied directly (or through priority interrupt circuitry) to the \overline{IRQ} input of the MPU. This is an "open drain" output (no load device on the chip) which permits other similar interrupt request lines to be tied together in a wire-OR configuration.

The \overline{IRQ} line is activated if, and only if, the Composite Interrupt Flag (Bit 7 of the Internal Status Register) is asserted. The conditions under which the \overline{IRQ} line is activated are discussed in conjunction with the Status Register.

• **Reset (\overline{RES})**

A "Low" level at this input is clocked into the PTM by the Enable (System ϕ_2) input. Two Enable pulses are required to synchronize and process the signal. The PTM then recognizes the active "Low" or inactive "High" on the third Enable pulse. If the \overline{RES} signal is asynchronous, an additional Enable period is required if setup times are not met. The \overline{RES} input must be stable "High"/"Low" for the minimum time stated in the AC Characteristics.

Recognition of a "Low" level at this input by the PTM causes the following action to occur:

- a. All counter latches are preset to their maximal count

values.

- b. All Control Register bits are cleared with the exception of CR10 (internal reset bit) which is set.
- c. All counters are preset to the contents of the latches.
- d. All counter outputs are reset and all counter clocks are disabled.
- e. All Status Register bits (interrupt flags) are cleared.

• **Register Select Lines (RS_0, RS_1, RS_2)**

These inputs are used in conjunction with the R/\bar{W} line to select the internal registers, counters and latches as shown in Table 1.

It has been previously stated that the PTM is accessed via MPU Load and Store operations in much the same manner as a memory device. The instructions available with the HMCS6800 family of MPUs which perform operations directly on memory should not be used when the PTM is accessed. These instructions actually fetch a byte from memory, perform an operation, then restore it to the same address location. Since the PTM used the R/\bar{W} line as an additional register select input, the modified data may not be restored to the same register if these instructions are used.

■ **PTM ASYNCHRONOUS INPUT/OUTPUT SIGNALS**

Each of the three timers within the PTM has external clock and gate inputs as well as a counter output line. The inputs are high impedance, TTL compatible lines and outputs are capable of driving two standard TTL loads.

• **Clock Inputs ($\bar{C}_1, \bar{C}_2, \bar{C}_3$)**

Input pins $\bar{C}_1, \bar{C}_2,$ and \bar{C}_3 will accept asynchronous TTL voltage level signals to decrement Timers 1, 2, and 3, respectively. The "High" and "Low" levels of the external clocks must each be stable for at least one system clock period plus the sum

Table 1 Register Selection

Register Select Inputs *			Operations	
RS_2	RS_1	RS_0	R/\bar{W} = "Low"	R/\bar{W} = "High"
L	L	L	CR20 = '0' Write Control Register #3 CR20 = '1' Write Control Register #1	No Operation
L	L	H	Write Control Register #2	Read Status Register
L	H	L	Write MSB Buffer Register	Read Timer #1 Counter
L	H	H	Write Timer #1 Latches	Read LSB Buffer Register
H	L	L	Write MSB Buffer Register	Read Timer #2 Counter
H	L	H	Write Timer #2 Latches	Read LSB Buffer Register
H	H	L	Write MSB Buffer Register	Read Timer #3 Counter
H	H	H	Write Timer #3 Latches	Read LSB Buffer Register

* L: "Low" level, H: "High" level

of the setup and hold times for the inputs. The asynchronous clock rate can vary from dc to the limit imposed by Enable (System ϕ_2) Setup, and Hold time.

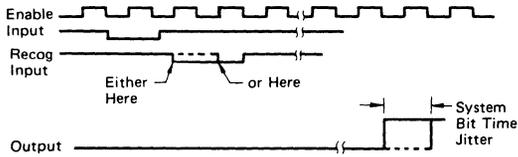
The external clock inputs are clocked in by Enable (System ϕ_2) pulses. Three Enable periods are used to synchronize and process the external clock. The fourth Enable pulse decrements the internal counter. This does not affect the input frequency, it merely creates a delay between a clock input transition and internal recognition of that transition by the PTM. All references to \bar{C} inputs in this document relate to internal recognition of the input transition. Note that a clock "High" or "Low" level which does not meet setup and hold time specifications may require an additional Enable pulse for recognition. When observing recurring events, a lack of synchronization will result in

"jitter" being observed on the output of the PTM when using asynchronous clocks and gate input signals. There are two types of jitter. "System jitter" is the result of the input signals being out of synchronization with the Enable (System ϕ_2), permitting signals with marginal setup and hold time to be recognized by either the bit time nearest the input transition or the subsequent bit time.

"Input jitter" can be as great as the time between input signal negative going transitions plus the system jitter, if the first transition is recognized during one system cycle, and not recognized the next cycle, or vice versa.

External clock input \bar{C}_3 represents a special case when Timer

#3 is programmed to utilize its optional $\div 8$ prescaler mode. The maximum input frequency and allowable duty cycles for this case are specified under the AC Characteristics. The output of the $\div 8$ prescaler is treated in the same manner as the previously discussed clock inputs. That is, it is clocked into the counter by Enable pulses, is recognized on the fourth Enable pulse (provided setup and hold time requirements are met), and must produce an output pulse at least as wide as the sum of an Enable period, setup, and hold times.



• Gate Inputs ($\overline{G}_1, \overline{G}_2, \overline{G}_3$)

Input pins \overline{G}_1 , \overline{G}_2 , and \overline{G}_3 accept asynchronous TTL-compatible signals which are used as triggers or clock gating functions to Timers 1, 2, and 3, respectively. The gating inputs are clocked into the PTM by the Enable (System ϕ_2) signal in the same manner as the previously discussed clock inputs. That is, a Gate transition is recognized by the PTM on the fourth Enable pulse (provided setup and hold time requirements are met), and the "High" or "Low" levels of the Gate input must be stable for at least one system clock period plus the sum of setup and hold times. All references to \overline{G} transition in this document relate to internal recognition of the input transition.

The Gate inputs of all timers directly affected the internal 16-bit counter. The operation of \overline{G}_3 is therefore independent of the $\div 8$ prescaler selection.

• Timer Outputs (O_1, O_2, O_3)

Timer outputs O_1 , O_2 , and O_3 are capable of driving up to two TTL loads and produce a defined output waveform for either Continuous or Single-Shot Timer modes. Output waveform definition is accomplished by selecting either Single 16-bit or Dual 8-bit operating modes. The single 16-bit mode will produce a square-wave output in the continuous timer mode and will produce a single pulse in the Single-Shot Timer mode. The Dual 8-bit mode will produce a variable duty cycle pulse in both the continuous and single shot Timer modes. "1" bit of each Control Register (CRX7) is used to enable the corresponding output. If this bit is cleared, the output will remain "Low" (V_{OL}) regardless of the operating mode.

If it is cleared while the output is high the output will go low during the first enable cycle following a write to the Control Register.

The Continuous and Single-Shot Timer Modes are the only ones for which output response is defined in this data sheet. Signals appear at the outputs (unless CRX7 = "0") during Frequency and Pulse Width comparison modes, but the actual waveform is not predictable in typical applications.

■ CONTROL REGISTER

Each timer in the HD6840 has a corresponding write-only Control Register. Control Register #2 has a unique address space (RS0="High", RS1="Low", RS2="Low") and therefore may be written into at any time. The remaining Control Registers (#1 and #3) share the Address Space selected by a "Low" level on all Register Select inputs.

• CR20

The least-significant bit of Control Register #2 (CR20) is used as an additional addressing bit for Control Registers #1 and

#3. Thus, with all Register selects and R/\overline{W} inputs at "Low" level. Control Register #1 will be written into if CR20 is a logic "1". Under the same conditions, control Register #3 can also be written into after a RES "Low" condition has occurred, since all control register bits (except CR10) are cleared. Therefore, one may write in the sequence CR3, CR2, CR1.

• CR10

The least-significant bit of Control Register #1 is used as an internal Reset bit. When this bit is a logic "0", all timers are allowed to operate in the modes prescribed by the remaining bits of the control registers. Writing a "1" into CR10 causes all counters to be preset with the contents of the corresponding counter latches, all counter clocks to be disabled, and the timer outputs and interrupt flags (Status Register) to be reset. Counter Latches and Control Registers are undisturbed by an Internal Reset and may be written into regardless of the state of CR10.

• CR30

The least-significant bit of Control Register #3 is used as a selector for a $\div 8$ prescaler which is available with Timer #3 only. The prescaler, if selected, is effectively placed between the clock input circuitry and the input to Counter #3. It can therefore be used with either the internal clock (Enable) or an external clock source.

• CRX1 ~ CRX7 (X=1~3)

The functions depicted in the foregoing discussions are tabulated in Table 2 for ease of reference.

Control Register Bits CR10, CR20, and CR30 are unique in that each selects a different function. The remaining bits (1 through 7) of each Control Register select common functions, with a particular Control Register affecting only its corresponding timer.

• CRX1

Bit 1 of Control Register #1 (CR11) selects whether an internal or external clock source is to be used with Timer #1. Similarly, CR21 selects the clock source for Timer #2, and CR31 performs this function for Timer #3. The function of each bit of Control Register "X" can therefore be defined as shown in the remaining section of Table 2.

• CRX2

Control Register Bit 2 selects whether the binary information contained in the Counter Latches (and subsequently loaded into the counter) is to be treated as a single 16-bit word or two 8-bit bytes. In the single 16-bit Counter Mode (CRX2=0) the counter will decrement to zero after $N + 1$ enabled (\overline{G} ="Low") clock periods, where N is defined as the 16-bit number in the Counter Latches. With CRX2 = 1, a similar Time Out will occur after $(L + 1) \cdot (M + 1)$ enabled clock periods, where L and M, respectively, refer to the LSB and MSB bytes in the Counter Latches.

• CRX3 ~ CRX7

Control Register Bits 3, 4, and 5 are explained in detail in the Timer Operating Mode section. Bit 6 is an interrupt mask bit which will be explained more fully in conjunction with the Status Register, and bit 7 is used to enable the corresponding Timer Output. A summary of the control register programming modes is shown in Table 3.

■ STATUS REGISTER/INTERRUPT FLAGS

The HD6840 has an internal Read-Only Status Register which contains four Interrupt Flags. (The remaining four bits of the register are not used, and default to "0"s when being read.) Bits 0, 1, and 2 are assigned to Timers 1, 2, and 3, respectively, as individual flag bits, while Bit 7 is a Composite Interrupt Flag. This flag bit will be asserted if any of the individual flag bits is

Table 2 Control Register Bits

CONTROL REGISTER #1		CONTROL REGISTER #2		CONTROL REGISTER #3	
CR10	Internal Reset Bit	CR20	Control Register Address Bit	CR30	Timer #3 Clock Control
"0" All timers allowed to operate "1" All timers held in preset state		"0" CR #3 may be written "1" CR #1 may be written		"0" T3 Clock is not prescaled "1" T3 Clock is prescaled by ÷ 8	
CRX1*		Timer #X Clock Source			
"0"		TX uses external clock source on \overline{CX} input			
"1"		TX uses Enable clock			
CRX2		Timer #X Counting Mode Control			
"0"		TX configured for normal (16-bit) counting mode			
"1"		TX configured for dual 8-bit counting mode			
CRX3 CRX4 CRX5		Timer #X Counter Mode and Interrupt Control (See Table 3)			
CRX6		Timer #X Interrupt Enable			
"0"		Interrupt Flag masked on \overline{IRQ}			
"1"		Interrupt Flag enabled on \overline{IRQ}			
CRX7		Timer #X Counter Output Enable			
"0"		TX Output masked on output OX			
"1"		TX Output enabled on output OX			

* Control Register for Timer 1, 2, or 3, Bit 1.

set while Bit 6 of the corresponding Control Register is at a logic "1". The conditions for asserting the Composite Interrupt Flag bit can therefore be expressed as:

$$INT = I_1 \cdot CR16 + I_2 \cdot CR26 + I_3 \cdot CR36$$

where INT = Composite Interrupt Flag (Bit 7)
 I_1 = Timer #1 Interrupt Flag (Bit 0)
 I_2 = Timer #2 Interrupt Flag (Bit 1)
 I_3 = Timer #3 Interrupt Flag (Bit 2)

STATUS REGISTER						
7	6	5	4	3	2	1 0
INT	/	/	/	/	I_3	$I_2 I_1$

An interrupt flag is cleared by a Timer Reset condition, i.e., External \overline{RES} = "Low" or Internal Reset Bit (CR10) = "1". It will also be cleared by a Read Timer Counter Command provided that the Status Register has previously been read while the interrupt flag was set. This condition on the Read Status Register - Read Timer Counter (RS-RT) sequence is designed to prevent missing interrupts which might occur after the status register is read, but prior to reading the Timer Counter.

An Individual Interrupt Flag is also cleared by a Write Timer Latches (W) command or a Counter Initialization (CI) sequence, provided that W or CI affects the Timer corresponding to the individual Interrupt Flag.

■ COUNTER LATCH INITIALIZATION

Each of the three independent timers consists of a 16-bit addressable counter and 16 bits of addressable latches. The counters are preset to the binary numbers stored in the latches. Counter initialization results in the transfer of the latch contents to the counter. See notes in Table 5 regarding the binary number N, L, or M placed into the Latches and their relationship to the output waveforms and counter Time-Outs.

Since the PTM data bus is 8-bits wide and the counters are 16-bits wide, a temporary register (MSB Buffer Register) is provided. This "write only" register is for the Most Significant

Byte of the desired latch data. Three addresses are provided for the MSB Buffer Register (as indicated in Table 1), but they all lead to the same Buffer. Data from the MSB Buffer will automatically be transferred into the Most Significant Byte of Timer #X when a Write Timer #X Latches Command is performed. So it can be seen that the HD6840 has been designed to allow transfer of two bytes of data into the counter latches provided that the MSB is transferred first.

In many applications, the source of the data will be as HMCS6800 MPU. It should be noted that the 16-bit store operations of the HMCS6800 microprocessors (STS and STX etc.) transfer data in the order required by the PTM. A Store Index Register Instruction, for example, results in the MSB of the X register being transferred to the selected address, then the LSB of the X register being written into the next higher location. Thus, either the index register or stack pointer may be transferred directly into a selected counter latch with a single instruction.

A logic "Low" at the \overline{RES} input also initializes the counter latches. In this case, all latches will assume a maximum count of (65,536)₁₀. It is important to note that an Internal Reset (Bit 0 of Control Register 1 Set) has no effect on the counter latches.

■ COUNTER INITIALIZATION

Counter Initialization is defined as the transfer of data from the latches to the counter with subsequent clearing of the Individual Interrupt Flag associated with the counter. Counter Initialization always occurs when a reset condition (\overline{RES} = "Low" or CR10 = "1") is recognized. It can also occur -- depending on Timer Mode -- with a Write Timer Latches command or recognition of a negative transition of the Gate input.

Counter recycling or re-initialization occurs when a negative transition of the clock input is recognized after the counter has reached an all-zero state. In this case, data is transferred from the Latches to the Counter.

■ TIMER OPERATING MODES

The HD6840 has been designed to operate effectively in a wide variety of applications. This is accomplished by using three bits of each control register (CRX3, CRX4, and CRX5) to

defined different operating modes of the Timers. These modes are divided into Wave Synthesis and Wave Measurement modes, and outlined in Table 4.

Table 4 Operating Modes

Control Register			Timer Operating Mode	
CRX3	CRX4	CRX5		
0	*	0	Continuous	Wave
0	*	1	Single-Shot	Synthesis
1	0	*	Frequency Comparison	Wave
1	1	*	Pulse Width Comparison	Measurement

* Defines Additional Timer Functions.

One of the WAVE SYNTHESIS modes is the Continuous Operating mode, which is useful for cyclic wave generation.

Either symmetrical or variable duty-cycle waves can be generated in this mode. The other wave synthesis mode, the Single-Shot mode, is similar in use to the Continuous operating mode, however, a single pulse is generated, with a programmable preset width.

The WAVE MEASUREMENT modes include the Frequency Comparison and Pulse Width Comparison modes which are used to measure cyclic and singular pulse widths, respectively.

In addition to the four timer modes in Table 4, the remaining control register bit is used to modify counter initialization and enabling or interrupt conditions.

■ WAVE SYNTHESIS MODES

● Continuous Operating Mode (Table 5)

The continuous mode will synthesize a continuous wave with

Table 3 Control Register Programming

								Register 1	Register 2	Register 3
7	6	5	4	3	2	1	0	"0" All Timers Operate	Reg #3 May Be Written	T3 Clk ÷ 1
X	X	X	X	X	X	X	†	"1" All Timers Preset	Reg #1 May Be Written	T3 Clk ÷ 8
7	6	5	4	3	2	1	0	"0" External Clock (\overline{CX} Input)		
X	X	X	X	X	X	†	X	"1" Internal Clock (Enable)		
7	6	5	4	3	2	1	0	"0" Normal (16-Bit) Count Mode		
X	X	X	X	X	†	X	X	"1" Dual 8-Bit Count Mode		
7	6	5	4	3	2	1	0	Continuous Operating Mode: $\overline{Gate} \downarrow$ or Write to Latches or Reset Causes Counter Initialization		
X	X	0	0	0	X	X	X			
7	6	5	4	3	2	1	0	Frequency Comparison Mode: Interrupt if $\overline{Gate} \uparrow$ is < Counter Time Out		
X	X	0	0	1	X	X	X			
7	6	5	4	3	2	1	0	Continuous Operating Mode: $\overline{Gate} \downarrow$ or Reset Causes Counter Initialization		
X	X	0	1	0	X	X	X			
7	6	5	4	3	2	1	0	Pulse Width Comparison Mode: Interrupt if $\overline{Gate} \uparrow$ is < Counter Time Out		
X	X	0	1	1	X	X	X			
7	6	5	4	3	2	1	0	Single Shot Mode: $\overline{Gate} \downarrow$ or Write to Latches or Reset Causes Counter Initialization		
1	X	1	0	0	X	X	X			
7	6	5	4	3	2	1	0	Frequency Comparison Mode: Interrupt If $\overline{Gate} \uparrow$ is > Counter Time Out		
X	X	1	0	1	X	X	X			
7	6	5	4	3	2	1	0	Single Shot Mode: $\overline{Gate} \downarrow$ or Reset Causes Counter Initialization		
1	X	1	1	0	X	X	X			
7	6	5	4	3	2	1	0	Pulse Width Comparison Mode: Interrupt If $\overline{Gate} \uparrow$ is > Counter Time Out		
X	X	1	1	1	X	X	X			
7	6	5	4	3	2	1	0	"0" Interrupt Flag Masked (\overline{IRQ})		
X	†	X	X	X	X	X	X	"1" Interrupt Flag Enabled (IRQ)		
7	6	5	4	3	2	1	0	"0" Timer Output Masked		
†	X	X	X	X	X	X	X	"1" Timer Output Enable		

(NOTE) Reset is Hardware or Software Reset (\overline{RES} = "Low" or CR10 = "1").

a period proportional to the preset number in the particular timer latches.

Any of the timers in the PTM may be programmed to operate in a continuous mode by writing "0"s into bits 3 and 5 of the corresponding control register. Assuming that the timer output is enabled (CRX7 = "1"), either a square wave or a variable duty cycle waveform will be generated at the Timer Output, OX. The type of output is selected via Control Register Bit 2.

Either a Timer Reset (CR10 = "1" or External \overline{RES} =

"Low") condition or internal recognition of a negative transition of the \overline{Gate} input results in Counter Initialization. A Write Timer Latches command can be selected as a Counter Initialization signal by clearing CRX4.

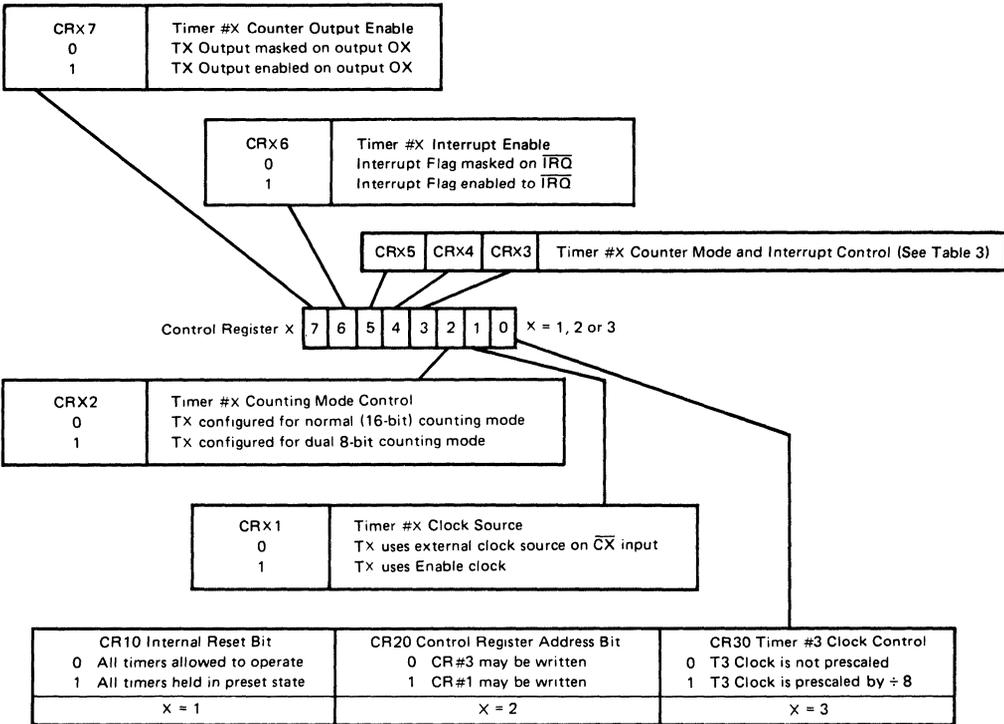
The counter is enabled by an absence of a Timer Reset condition and a "Low" level at the \overline{Gate} input. In the 16-bit mode, the counter will decrement on the first clock cycle during or after the counter initialization cycle. It continues to decrement on each clock signal so long as \overline{G} remains "Low" and no reset condition exists. A Counter Time Out (the first clock after all

Table 5 Continuous Operating Modes

CONTINUOUS MODE (CRX3 = "0", CRX5 = "0")			Initialization/Output Waveforms
Control Register		Counter Initialization	*Timer Output (OX) (CRX7 = "1")
CRX2	CRX4		
0	0	$\overline{G}\downarrow+W+R$	
0	1	$\overline{G}\downarrow+R$	
1	0	$\overline{G}\downarrow+W+R$	
1	1	$\overline{G}\downarrow+R$	

$\overline{G}\downarrow$ = Negative transition of \overline{Gate} input.
 W = Write Timer Latches Command.
 R = Timer Reset (CR10 = "1" or External \overline{RES} = "Low")
 N = 16-Bit Number in Counter Latch.
 L = 8-Bit Number in LSB Counter Latch.
 M = 8-Bit Number in MSB Counter Latch.
 T = Clock Input Negative Transitions to Counter.
 t_0 = Counter Initialization Cycle.
 TO = Counter Time Out (All Zero Condition).
 * All time intervals shown above assume the \overline{Gate} (\overline{G}) and \overline{Clock} (\overline{C}) signals are synchronized to Enable (System ϕ_1) with the specified setup and hold time requirements.

Control Register Bits



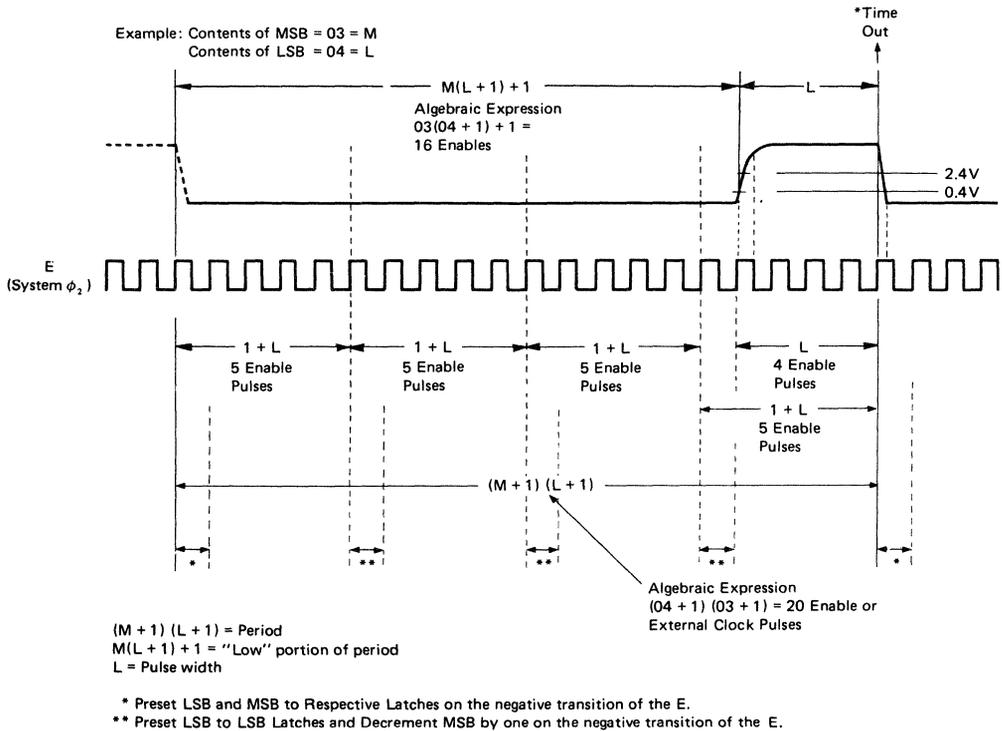


Figure 9 Timer Output Waveform Example
(Continuous Dual 8-Bit Mode using Internal Enable)

counter bits = "0") results in the Individual Interrupt Flag being set and re-initialization of the counter.

In the dual 8-bit mode (CRX2 = "1") [Refer to the example in Fig. 9] the MSB decrements once for every full countdown of the LSB + 1. When the LSB = "0", the MSB is unchanged; on the next clock pulse the LSB is reset to the count in the LSB Latches and the MSB is decremented by 1 (one). The output, if enabled, remains "Low" during and after initialization and will remain "Low" until the counter MSB is all "0"s. The output will go "High" at the beginning of the next clock pulse. The output remains "High" until both the LSB and MSB of the counter are all "0"s. At the beginning of the next clock pulse the defined Time Out (TO) will occur and the output will go "Low". In the Dual 8-bit mode the period of the output of the example in Fig. 9 would span 20 clock pulses as opposed to the 1546 clock pulses using the Normal 16-bit mode.

A special time-out condition exists for the dual 8-bit mode (CRX2 = "1") if L = "0". In this case, the counter will revert to a mode similar to the single 16-bit mode, except Time Out occurs after M+1 clock pulses. The output, if enabled, goes "Low" during the Counter Initialization cycle and reverses state at each Time Out. The counter remains cyclical (is re-initialized at each Time Out) and the Individual Interrupt Flag is set when Time Out occurs. If M = L = "0", the internal counters do not change, but the output toggles at a rate of 1/2 the clock frequency.

The discussion of the Continuous Mode has assumed that the

application requires an output signal. It should be noted that the Timer operates in the same manner with the output disabled (CRX7 = "0"). A Read Timer Counter command is valid regardless of the state of CRX7.

• Single-Shot Timer Mode

This mode is identical to the Continuous Mode with three exceptions. The first of these is obvious from the name — the output returns to a "Low" level after the initial Time Out and remains "Low" until another Counter Initialization cycle occurs. The waveforms available are shown in Table 6.

As indicated in Table 6, the internal counting mechanism remains cyclical in the Single-Shot Mode. Each Time Out of the counter results in the setting of an Individual Interrupt Flag and re-initialization of the counter.

The second major difference between the Single-Shot and Continuous modes is that the internal counter enable is not dependent on the Gate input level remaining in the "Low" state for the Single-Shot mode.

Another special condition is introduced in the Single-Shot mode. If L = M = "0" (Dual 8-bit) or N = "0" (Single 16-bit), the output goes "Low" on the first clock received during or after Counter Initialization. The output remains "Low" until the Operating Mode is changed or nonzero data is written into the Counter Latches. Time Outs continue to occur at the end of each clock period.

The three differences between Single-Shot and Continuous Timer Modes can be summarized as attributes of the Single-Shot

mode:

1. Output is enabled for only one pulse until it is reinitialized.

2. Counter Enable is independent of $\overline{\text{Gate}}$.
3. $L = M = "0"$ or $N = "0"$ disables output.

Aside from these differences, the two modes are identical.

Table 6 Single-Shot Operating Modes

Single-Shot Mode (CRX3 = "0", CRX7 = "1", CRX5 = "1")			
Control Register		Initialization/Output Waveforms	
CRX2	CRX4	Counter Initialization	Timer Output (OX)
0	0	$\overline{\text{G}}_i + \text{W} + \text{R}$	
0	1	$\overline{\text{G}}_i + \text{R}$	
1	0	$\overline{\text{G}}_i + \text{W} + \text{R}$	
1	1	$\overline{\text{G}}_i + \text{R}$	

Symbols are as defined in Table 5.

■ Wave Measurement Modes

The Wave Measurement Modes are the Frequency (period) Measurement and Pulse Width Comparison Modes, and are provided for those applications which require more flexibility of interrupt generation and Counter Initialization. Individual Interrupt Flags are set in these modes as a function of both Counter Time Out and transitions of the Gate input. Counter Initialization is also affected by Interrupt Flag status.

A timer's output is normally not used in a Wave Measurement mode, but it is defined. If the output is enabled, it will

operate as follows. During the period between reinitialization of the timer and the first Time Out, the output will be a logical zero. If the first Time Out is completed (regardless of its method of generation), the output will go "High". If further TO's occur, the output will change state at each completion of a Time-Out.

The counter does operate in either Single 16-bit or Dual 8-bit modes as programmed by CRX2. Other features of the Wave Measurement Modes are outlined in Table 7.

Table 7 Wave Measurement Modes

CRX3 = "1"			
CRX4	CRX5	Application	Condition for Setting Individual Interrupt Flag
0	0	Frequency Comparison	Interrupt Generated if Gate Input Period (1/F) is less than Counter Time Out (TO)
0	1	Frequency Comparison	Interrupt Generated if $\overline{\text{Gate}}$ Input Period (1/F) is greater than Counter Time Out (TO)
1	0	Pulse Width Comparison	Interrupt Generated if Gate Input "Down Time" is less than Counter Time Out (TO)
1	1	Pulse Width Comparison	Interrupt Generated if Gate Input "Down Time" is greater than Counter Time Out (TO)

● Frequency Comparison or Period Measurement Mode (CRX3 = "1", CRX4 = "0")

The Frequency Comparison Mode with CRX5 = "1" is straightforward. If Time Out occurs prior to the first negative transition of the $\overline{\text{Gate}}$ input after a Counter Initialization cycle, an Individual Interrupt Flag is set. The counter is disabled, and a Counter Initialization cycle cannot begin until the interrupt flag is cleared and a negative transition on $\overline{\text{G}}$ is detected.

If CRX5 = "0", as shown in Table 7 and Table 8, an interrupt is generated if $\overline{\text{Gate}}$ input returns "Low" prior to a Time Out. If Counter Time-Out occurs first, the counter is recycled and continues to decrement. A bit is set within the timer on the initial Time Out which precludes further individual interrupt generation until a new Counter Initialization cycle has been completed. When this internal bit is set, a negative transition of the $\overline{\text{Gate}}$ input starts a new Counter Initialization cycle. (The

condition of $\overline{\text{G}}_i \cdot \overline{\text{T}} \cdot \text{TO}$ is satisfied, since a Time Out has occurred and no individual Interrupt has been generated.)

Any of the timers within the PTM may be programmed to compare the period of a pulse (giving the frequency after calculations) at the Gate input with the time period requested for Counter Time-Out. A negative transition of the Gate input enables the counter and starts a Counter Initialization cycle – provided that other conditions as noted in Table 8 are satisfied. The counter decrements on each clock signal recognized during or after Counter Initialization until an Interrupt is generated, a Write Timer Latches command is issued, or a Timer Reset condition occurs. It can be seen from Table 8 that an interrupt condition will be generated if CRX5 = "0" and the period of the pulse (single pulse or measured separately repetitive pulses) at the Gate input is less than the Counter Time Out period. If CRX5 = "1", an interrupt is generated if the reverse is true.

Assume now with CRX5 = "1" that a Counter Initialization has occurred and that the $\overline{\text{Gate}}$ input has returned "Low" prior to Counter Time Out. Since there is no Individual Interrupt Flag generated, this automatically starts a new Counter Initialization Cycle. The process will continue with frequency comparison being performed on each $\overline{\text{Gate}}$ input cycle until the mode is changed, or a cycle is determined to be above the predetermined limit.

● **Pulse Width Comparison Mode (CRX3 = "1", CRX4 = "1")**

This mode is similar to the Frequency Comparison Mode except for a positive, rather than negative, transition of the $\overline{\text{Gate}}$

input terminates the count. With CRX5 = "0", an Individual Interrupt Flag will be generated if the "Low" level pulse applied to the $\overline{\text{Gate}}$ input is less than the time period required for Counter Time Out. With CRX5 = "1", the interrupt is generated when the reverse condition is true.

As can be seen in Table 9, a positive transition of the $\overline{\text{Gate}}$ input disables the counter. With CRX5 = "0", it is therefore possible to directly obtain the width of any pulse causing an interrupt. Similar data for other Time Interval Modes and conditions can be obtained, if two sections of the PTM are dedicated to the purpose.

Table 8 Frequency Comparison Mode

CRX3 = "1", CRX4 = "0"				
Control Reg Bit 5 (CRX5)	Counter Initialization	Counter Enable Flip-Flop Set (CE)	Counter Enable Flip-Flop Reset (CE)	Interrupt Flag Set (I)
0	$\overline{\text{G}}_i \cdot \overline{\text{T}} \cdot (\overline{\text{CE}} + \text{TO}) + \text{R}$	$\overline{\text{G}}_i \cdot \overline{\text{W}} \cdot \overline{\text{R}} \cdot \overline{\text{T}}$	W+R+I	$\overline{\text{G}}_i$ Before TO
1	$\overline{\text{G}}_i \cdot \overline{\text{T}} + \text{R}$	$\overline{\text{G}}_i \cdot \overline{\text{W}} \cdot \overline{\text{R}} \cdot \overline{\text{T}}$	W+R+I	TO Before $\overline{\text{G}}_i$

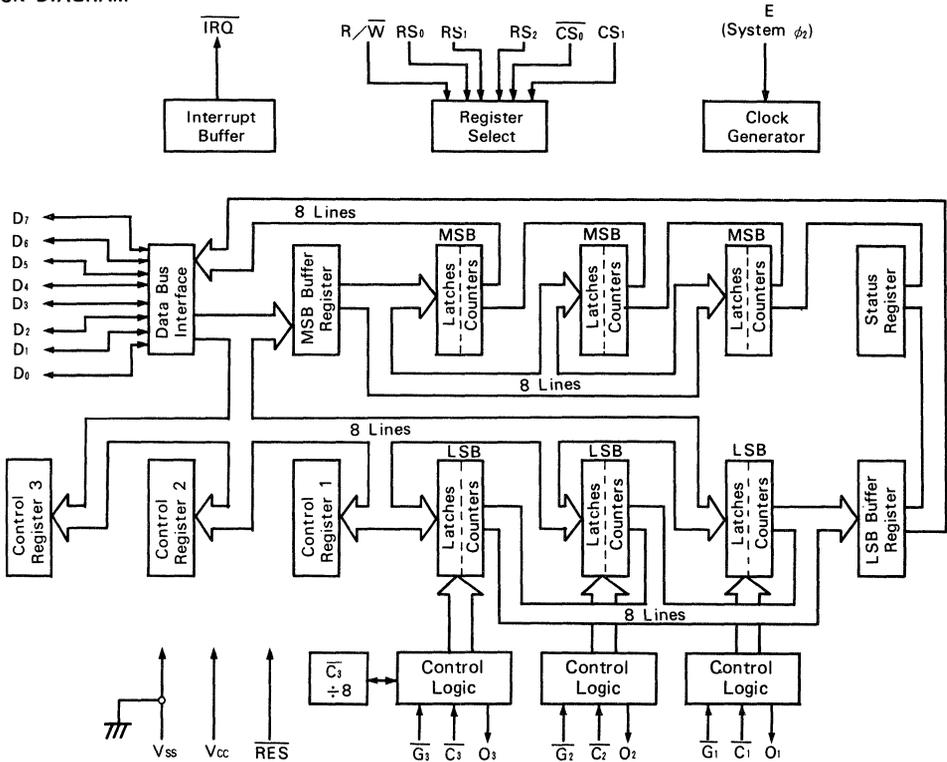
I represents the interrupt for a given timer.

Table 9 Pulse Width Comparison Mode

CRX3 = "1", CRX4 = "1"				
Control Reg Bit 5 (CRX5)	Counter Initialization	Counter Enable Flip-Flop Set (CE)	Counter Enable Flip-Flop Reset (CE)	Interrupt Flag Set (I)
0	$\overline{\text{G}}_i \cdot \overline{\text{T}} + \text{R}$	$\overline{\text{G}}_i \cdot \overline{\text{W}} \cdot \overline{\text{R}} \cdot \overline{\text{T}}$	W+R+I+G	$\overline{\text{G}}_i$ Before TO
1	$\overline{\text{G}}_i \cdot \overline{\text{T}} + \text{R}$	$\overline{\text{G}}_i \cdot \overline{\text{W}} \cdot \overline{\text{R}} \cdot \overline{\text{T}}$	W+R+I+G	TO Before $\overline{\text{G}}_i$

G = Level sensitive recognition of $\overline{\text{Gate}}$ input.

■ BLOCK DIAGRAM



■ ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Value	Unit
Supply Voltage	V_{CC}^*	-0.3~+7.0	V
Input Voltage	V_{in}^*	-0.3~+7.0	V
Maximum Output Current	$ \text{I}_\text{O} ^{**}$	10	mA
Operating Temperature	T_{opr}	-20~+75	$^\circ\text{C}$
Storage Temperature	T_{stg}	-55~+150	$^\circ\text{C}$

* With respect to V_{SS} (SYSTEM GND)

** Maximum output current is the maximum currents which can flow out from one output terminal or I/O common terminal. ($\text{D}_0 \sim \text{D}_7$, $\text{O}_1 \sim \text{O}_3$, $\overline{\text{IRQ}}$)

[NOTE] Permanent LSI damage may occur if maximum ratings are exceeded. Normal operation should be under recommended operating conditions. If these conditions are exceeded, it could affect reliability of LSI.

■ RECOMMENDED OPERATING CONDITIONS

Item	Symbol	min	typ	max	Unit
Supply Voltage	V_{CC}^*	4.5	5.0	5.5	V
Input Voltage	V_{IL}^*	0	—	0.8	V
	V_{IH}^*	2.0	—	V_{CC}	V
Operating Temperature	T_{opr}	-20	25	75	$^\circ\text{C}$

* With respect to V_{SS} (SYSTEM GND)

■ ELECTRICAL CHARACTERISTICS

● DC CHARACTERISTICS ($V_{CC} = 5V \pm 10\%$, $V_{SS} = 0V$, $T_a = -20 \sim +75^\circ C$, unless otherwise noted.)

Item	Symbol	Test Condition	min	typ*	max	Unit	
Input "High" Voltage	V_{IH}		2.0	—	V_{CC}	V	
Input "Low" Voltage	V_{IL}		-0.3	—	0.8	V	
Input Leakage Current	I_{in}	$V_{in} = 0 \sim V_{CC}$ (Except $D_0 \sim D_7$)	-2.5	—	2.5	μA	
Three-State Input Current (off-state)	I_{TSI}	$V_{in} = 0.4 \sim V_{CC}$, $V_{CC} = 5.5V$ ($D_0 \sim D_7$)	-10	—	10	μA	
Output "High" Voltage	V_{OH}	$I_{LOAD} = -400 \mu A$ ($D_0 \sim D_7$)	4.1	—	—	V	
		$I_{LOAD} \leq -10 \mu A$ ($D_0 \sim D_7$)	$V_{CC}-0.1$	—	—		
		$I_{LOAD} = -400 \mu A$ (Other Outputs)	4.1	—	—		
		$I_{LOAD} \leq -10 \mu A$ (Other Outputs)	$V_{CC}-0.1$	—	—		
Output "Low" Voltage	V_{OL}	$I_{LOAD} = 1.6 mA$ ($D_0 \sim D_7$)	—	—	0.4	V	
		$I_{LOAD} = 3.2 mA$ ($O_1 \sim O_3, \overline{IRQ}$)	—	—	—		
Output Leakage Current (off-state)	I_{LOH}	$V_{OH} = V_{CC}$ (\overline{IRQ})	—	—	10	μA	
Supply Current	I_{CC}	<ul style="list-style-type: none"> • Chip is not selected. • All counter latches are preset. • $O_1 \sim O_3$ outputs are masked. • Input level (Except E) <ul style="list-style-type: none"> $V_{IH} \text{ min} = V_{CC}-0.8V$ $V_{IL} \text{ max} = 0.8V$ 	E = 1.0 MHz	—	—	1.0	mA
			E = 1.5 MHz	—	—	1.5	
			E = 2.0 MHz	—	—	2.0	
		<ul style="list-style-type: none"> • Chip is not selected. • Counters are operating. • $O_1 \sim O_3$ operating with load. • Input level (Except E) <ul style="list-style-type: none"> $V_{IH} \text{ min} = V_{CC}-0.8V$ $V_{IL} \text{ max} = 0.8V$ 	E = 1.0 MHz	—	—	3.0	
			E = 1.5 MHz	—	—	4.0	
			E = 2.0 MHz	—	—	6.0	
		<ul style="list-style-type: none"> • Data bus in R/W operation. • Counters are operating. • $O_1 \sim O_3$ operating with load. 	E = 1.0 MHz	—	—	5.0	
			E = 1.5 MHz	—	—	8.0	
			E = 2.0 MHz	—	—	10.0	
		Input Capacitance	C_{in}	$V_{in} = 0V$, $T_a = 25^\circ C$, $f = 1 MHz$	$D_0 \sim D_7$	—	
Other Input	—				—	7.5	
Output Capacitance	C_{out}	$V_{in} = 0V$, $T_a = 25^\circ C$, $f = 1 MHz$	\overline{IRQ}	—	—	5.0	pF
			O_1, O_2, O_3	—	—	10	

* $T_a = 25^\circ C$, $V_{CC} = 5.0V$

- AC CHARACTERISTICS ($V_{CC} = 5V \pm 10\%$, $V_{SS} = 0V$, $T_a = -20 \sim +75^\circ C$, unless otherwise noted.)

1. MPU READ TIMING

Item	Symbol	Test Condition	HD6340			HD63A40			HD63B40			Unit
			min	typ	max	min	typ	max	min	typ	max	
Enable Cycle Time	t_{cycE}	Fig. 1	1000	—	10000	666	—	10000	500	—	10000	ns
Enable "High" Pulse Width	PW_{EH}		450	—	9500	280	—	9500	220	—	9500	ns
Enable "Low" Pulse Width	PW_{EL}		430	—	9500	280	—	9500	210	—	9500	ns
Enable Rise and Fall Time	t_{Er}, t_{Ef}		—	—	25	—	—	25	—	—	20	ns
Address Set Up Time	t_{AS}		80	—	—	60	—	—	40	—	—	ns
Data Delay Time	t_{DDR}		—	—	290	—	—	180	—	—	150	ns
Data Hold Time	t_{HR}		20	—	100	20	—	100	20	—	100	ns
Address Hold Time	t_{AH}		10	—	—	10	—	—	10	—	—	ns
Data Access Time	t_{ACC}		—	—	370	—	—	240	—	—	190	ns

2. MPU WRITE TIMING

Item	Symbol	Test Condition	HD6340			HD63A40			HD63B40			Unit
			min	typ	max	min	typ	max	min	typ	max	
Enable Cycle Time	t_{cycE}	Fig. 2	1000	—	10000	666	—	10000	500	—	10000	ns
Enable "High" Pulse Width	PW_{EH}		450	—	9500	280	—	9500	220	—	9500	ns
Enable "Low" Pulse Width	PW_{EL}		430	—	9500	280	—	9500	210	—	9500	ns
Enable Rise and Fall Time	t_{Er}, t_{Ef}		—	—	25	—	—	25	—	—	20	ns
Address Set Up Time	t_{AS}		80	—	—	60	—	—	40	—	—	ns
Data Set Up Time	t_{DSW}		165	—	—	80	—	—	60	—	—	ns
Data Hold Time	t_{HW}		10	—	—	10	—	—	10	—	—	ns
Address Hold Time	t_{AH}		10	—	—	10	—	—	10	—	—	ns

3. TIMING OF PTM SIGNAL

Item	Symbol	Test Condition	HD6340		HD63A40		HD63B40		Unit
			min	max	min	max	min	max	
Input Rise and Fall Times	$\overline{C}, \overline{G}, \overline{RES}$	t_r, t_f	—	1000*	—	666*	—	500*	ns
Input "Low" Pulse Width	$\overline{C}, \overline{G}, \overline{RES}$	PW_L	$t_{cycE} + t_{SU} + t_{HD}$	—	$t_{cycE} + t_{SU} + t_{HD}$	—	$t_{cycE} + t_{SU} + t_{HD}$	—	ns
Input "High" Pulse Width	$\overline{C}, \overline{G}$	PW_H	$t_{cycE} + t_{SU} + t_{HD}$	—	$t_{cycE} + t_{SU} + t_{HD}$	—	$t_{cycE} + t_{SU} + t_{HD}$	—	ns
Input Setup Time	$\overline{C}, \overline{G}, \overline{RES}$	t_{SU}	Fig. 5 (Synchronous Mode)	200	—	120	—	75	—
	\overline{C}_3 ($\div 8$ Prescaler Mode)			200	—	170	—	170	—
Input Hold Time	$\overline{C}, \overline{G}, \overline{RES}$	t_{HD}	Fig. 5 (Synchronous Mode)	50	—	50	—	50	—
	\overline{C}_3 ($\div 8$ Prescaler Mode)			50	—	50	—	50	—
Input Pulse Width	\overline{C}_3 ($\div 8$ Prescaler Mode)	PW_L, PW_H	(Asynchronous Mode)	120	—	80	—	60	—
Output Delay Time	$O_1 \sim O_3$	t_{co}	Fig. 6	—	200	—	200	—	200
Interrupt Release Time		t_{IR}	Fig. 7	—	1200	—	900	—	700

* $t_r, t_f \leq t_{cycE}$

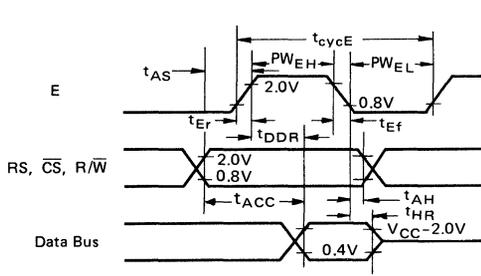


Figure 1 Bus Read Timing (Read Information from PTM)

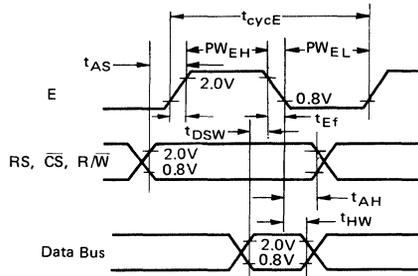


Figure 2 Bus Write Timing (Write Information into PTM)

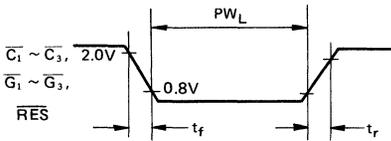


Figure 3 Input Pulse Width "Low"

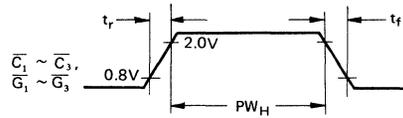


Figure 4 Input Pulse Width "High"

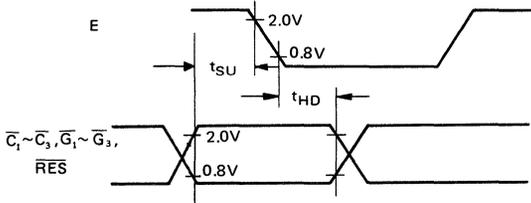


Figure 5 Input Setup and Hold Times

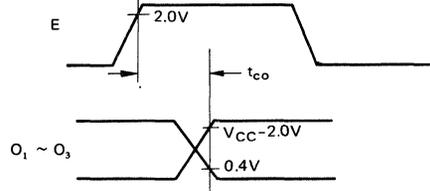


Figure 6 Output Delay

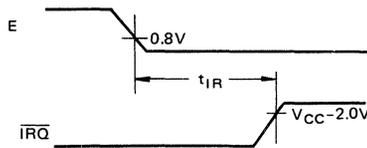


Figure 7 $\overline{I_{RQ}}$ Release Time

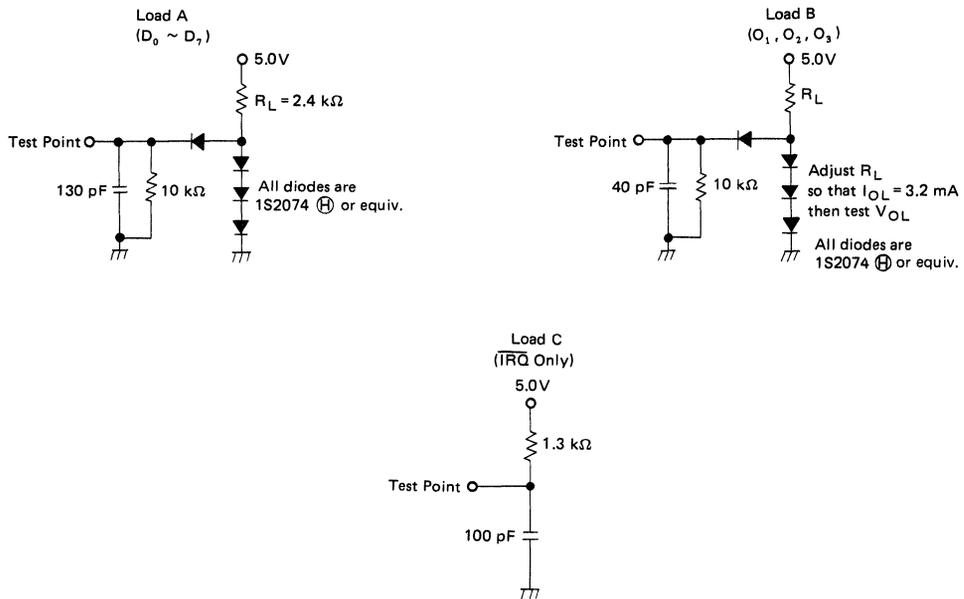


Figure 8 Test Loads

■ GENERAL DESCRIPTION

The HD6340 is part of the HMCS6800 microprocessor family and is fully bus compatible with HD6800 systems. The three timers in the HD6340 operate independently and in several distinct modes to fit a wide variety of measurement and synthesis applications.

The HD6340 is an integrated set of three distinct counter/timers. It consists of three 16-bit data latches, three 16-bit counters (clocked independently), and the comparison and enable circuitry necessary to implement various measurement and synthesis functions. In addition, it contains interrupt drivers to alert the processor that a particular function has been completed.

In a typical application, a timer will be loaded by first storing two bytes of data into an associated Counter Latch. This data is then transferred into the counter via a Counter initialization cycle. If the counter is enabled, the counter decrements on each subsequent clock period which may be an external clock, or Enable (E) until one of several predetermined conditions causes it to halt or recycle. The timers are thus programmable, cyclic in nature, controllable by external inputs or the MPU program, and accessible by the MPU at any time.

■ PTM INTERFACE SIGNALS FOR MPU

The Programmable Timer Module (PTM) interfaces to the HMCS6800 Bus with an eight-bit bidirectional data bus, two

Chip Select lines, a Read/Write line, an Enable (System ϕ_2) line, an Interrupt Request line, an external Reset line, and three Register Select lines. These signals, in conjunction with the HD6800 VMA output, permit the MPU to control the PTM. VMA should be utilized in conjunction with an MPU address line into a Chip Select of the PTM, when the HD6800, HD6802 are used.

● Bidirectional Data ($D_0 \sim D_7$)

The bidirectional data lines ($D_0 \sim D_7$) allow the transfer of data between the MPU and PTM. The data bus output drivers are three-state devices which remain in the high-impedance (off) state except when the MPU performs a PTM read operation (Read/Write and Enable lines "High" and PTM Chip Selects activated).

● Chip Select (\overline{CS}_0, CS_1)

These two signals are used to activate the Data Bus interface and allow transfer of data from the PTM. With \overline{CS}_0 = "Low" and CS_1 = "High", the device is selected and data transfer will occur.

● Read/Write (R/\overline{W})

This signal is generated by the MPU to control the direction of data transfer on the Data Bus. With the PTM selected, a "Low" state on the PTM R/\overline{W} line enables the input buffers and

data is transferred from the MPU to the PTM on the trailing edge of the Enable (System ϕ_2) signal. Alternately, (under the same conditions) R/\bar{W} = "High" and Enable "High" allows data in the PTM to be read by the MPU.

• **Enable (E)**

This signal synchronizes data transfer between the MPU and the PTM. It also performs an equivalent synchronization function on the external clock, reset, and gate inputs of the PTM.

• **Interrupt Request (\bar{IRQ})**

The active "Low" Interrupt Request signal is normally tied directly (or through priority interrupt circuitry) to the \bar{IRQ} input of the MPU. This is an "open drain" output (no load device on the chip) which permits other similar interrupt request lines to be tied together in a wire-OR configuration.

The \bar{IRQ} line is activated if, and only if, the Composite Interrupt Flag (Bit 7 of the Internal Status Register) is asserted. The conditions under which the \bar{IRQ} line is activated are discussed in conjunction with the Status Register.

• **Reset (\bar{RES})**

A "Low" level at this input is clocked into the PTM by the Enable (System ϕ_2) input. Two Enable pulses are required to synchronize and process the signal. The PTM then recognizes the active "Low" or inactive "High" on the third Enable pulse. If the \bar{RES} signal is asynchronous, an additional Enable period is required if setup times are not met. The \bar{RES} input must be stable "High"/"Low" for the minimum time stated in the AC Characteristics.

Recognition of a "Low" level at this input by the PTM causes the following action to occur:

- a. All counter latches are preset to their maximal count

values.

- b. All Control Register bits are cleared with the exception of CR10 (internal reset bit) which is set.
- c. All counters are preset to the contents of the latches.
- d. All counter outputs are reset and all counter clocks are disabled.
- e. All Status Register bits (interrupt flags) are cleared.

• **Register Select Lines (RS_0, RS_1, RS_2)**

These inputs are used in conjunction with the R/\bar{W} line to select the internal registers, counters and latches as shown in Table 1.

It has been previously stated that the PTM is accessed via MPU Load and Store operations in much the same manner as a memory device. The instructions available with the HMCS6800 family of MPUs which perform operations directly on memory should not be used when the PTM is accessed. These instructions actually fetch a byte from memory, perform an operation, then restore it to the same address location. Since the PTM used the R/\bar{W} line as an additional register select input, the modified data may not be restored to the same register if these instructions are used.

■ **PTM ASYNCHRONOUS INPUT/OUTPUT SIGNALS**

Each of the three timers within the PTM has external clock and gate inputs as well as a counter output line. The inputs are high impedance, TTL compatible lines and outputs are capable of driving two standard TTL loads.

• **Clock Inputs ($\bar{C}_1, \bar{C}_2, \bar{C}_3$)**

Input pins $\bar{C}_1, \bar{C}_2,$ and \bar{C}_3 will accept asynchronous TTL voltage level signals to decrement Timers 1, 2, and 3, respectively. The "High" and "Low" levels of the external clocks must each be stable for at least one system clock period plus the sum

Table 1 Register Selection

Register Select Inputs *			Operations	
RS_2	RS_1	RS_0	R/\bar{W} = "Low"	R/\bar{W} = "High"
L	L	L	CR20 = "0" Write Control Register #3 CR20 = "1" Write Control Register #1	All bits "0"
L	L	H	Write Control Register #2	Read Status Register
L	H	L	Write MSB Buffer Register	Read Timer #1 Counter
L	H	H	Write Timer #1 Latches	Read LSB Buffer Register
H	L	L	Write MSB Buffer Register	Read Timer #2 Counter
H	L	H	Write Timer #2 Latches	Read LSB Buffer Register
H	H	L	Write MSB Buffer Register	Read Timer #3 Counter
H	H	H	Write Timer #3 Latches	Read LSB Buffer Register

* L: "Low" level, H: "High" level

of the setup and hold times for the inputs. The asynchronous clock rate can vary from dc to the limit imposed by Enable (System ϕ_2) Setup, and Hold time.

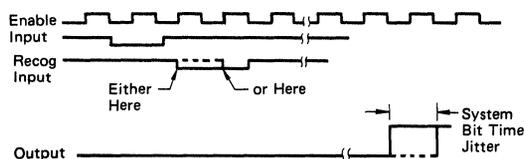
The external clock inputs are clocked in by Enable (System ϕ_2) pulses. Three Enable periods are used to synchronize and process the external clock. The fourth Enable pulse decrements the internal counter. This does not affect the input frequency, it merely creates a delay between a clock input transition and internal recognition of that transition by the PTM. All references to \bar{C} inputs in this document relate to internal recognition of the input transition. Note that a clock "High" or "Low" level which does not meet setup and hold time specifications may require an additional Enable pulse for recognition. When observing recurring events, a lack of synchronization will result in

"jitter" being observed on the output of the PTM when using asynchronous clocks and gate input signals. There are two types of jitter. "System jitter" is the result of the input signals being out of synchronization with the Enable (System ϕ_2), permitting signals with marginal setup and hold time to be recognized by either the bit time nearest the input transition or the subsequent bit time.

"Input jitter" can be as great as the time between input signal negative going transitions plus the system jitter, if the first transition is recognized during one system cycle, and not recognized the next cycle, or vice versa.

External clock input \bar{C}_3 represents a special case when Timer

#3 is programmed to utilize its optional $\div 8$ prescaler mode. The maximum input frequency and allowable duty cycles for this case are specified under the AC Characteristics. The output of the $\div 8$ prescaler is treated in the same manner as the previously discussed clock inputs. That is, it is clocked into the counter by Enable pulses, is recognized on the fourth Enable pulse (provided setup and hold time requirements are met), and must produce an output pulse at least as wide as the sum of an Enable period, setup, and hold times.



• Gate Inputs ($\overline{G}_1, \overline{G}_2, \overline{G}_3$)

Input pins \overline{G}_1 , \overline{G}_2 , and \overline{G}_3 accept asynchronous TTL-compatible signals which are used as triggers or clock gating functions to Timers 1, 2, and 3, respectively. The gating inputs are clocked into the PTM by the Enable (System ϕ_2) signal in the same manner as the previously discussed clock inputs. That is, a Gate transition is recognized by the PTM on the fourth Enable pulse (provided setup and hold time requirements are met), and the "High" or "Low" levels of the Gate input must be stable for at least one system clock period plus the sum of setup and hold times. All references to \overline{G} transition in this document relate to internal recognition of the input transition.

The \overline{G} inputs of all timers directly affected the internal 16-bit counter. The operation of \overline{G}_3 is therefore independent of the $\div 8$ prescaler selection.

• Timer Outputs (O_1, O_2, O_3)

Timer outputs O_1 , O_2 , and O_3 are capable of driving up to two TTL loads and produce a defined output waveform for either Continuous or Single-Shot Timer modes. Output waveform definition is accomplished by selecting either Single 16-bit or Dual 8-bit operating modes. The single 16-bit mode will produce a square-wave output in the continuous timer mode and will produce a single pulse in the Single-Shot Timer mode. The Dual 8-bit mode will produce a variable duty cycle pulse in both the continuous and single shot Timer modes. "1" bit of each Control Register (CRX7) is used to enable the corresponding output. If this bit is cleared, the output will remain "Low" (V_{OL}) regardless of the operating mode.

If it is cleared while the output is high the output will go low during the first enable cycle following a write to the Control Register.

The Continuous and Single-Shot Timer Modes are the only ones for which output response is defined in this data sheet. Signals appear at the outputs (unless CRX7 = "0") during Frequency and Pulse Width comparison modes, but the actual waveform is not predictable in typical applications.

■ CONTROL REGISTER

Each timer in the HD6340 has a corresponding write-only Control Register. Control Register #2 has a unique address space (RS0="High", RS1="Low", RS2="Low") and therefore may be written into at any time. The remaining Control Registers (#1 and #3) share the Address Space selected by a "Low" level on all Register Select inputs.

• CR20

The least-significant bit of Control Register #2 (CR20) is used as an additional addressing bit for Control Registers #1 and

#3. Thus, with all Register selects and R/W inputs at "Low" level. Control Register #1 will be written into if CR20 is a logic "1". Under the same conditions, control Register #3 can also be written into after a RES "Low" condition has occurred, since all control register bits (except CR10) are cleared. Therefore, one may write in the sequence CR3, CR2, CR1.

• CR10

The least-significant bit of Control Register #1 is used as an internal Reset bit. When this bit is a logic "0", all timers are allowed to operate in the modes prescribed by the remaining bits of the control registers. Writing a "1" into CR10 causes all counters to be preset with the contents of the corresponding counter latches, all counter clocks to be disabled, and the timer outputs and interrupt flags (Status Register) to be reset. Counter Latches and Control Registers are undisturbed by an Internal Reset and may be written into regardless of the state of CR10.

• CR30

The least-significant bit of Control Register #3 is used as a selector for a $\div 8$ prescaler which is available with Timer #3 only. The prescaler, if selected, is effectively placed between the clock input circuitry and the input to Counter #3. It can therefore be used with either the internal clock (Enable) or an external clock source.

• CRX1 ~ CRX7 (X=1~3)

The functions depicted in the foregoing discussions are tabulated in Table 2 for ease of reference.

Control Register Bits CR10, CR20, and CR30 are unique in that each selects a different function. The remaining bits (1 through 7) of each Control Register select common functions, with a particular Control Register affecting only its corresponding timer.

• CRX1

Bit 1 of Control Register #1 (CR11) selects whether an internal or external clock source is to be used with Timer #1. Similarly, CR21 selects the clock source for Timer #2, and CR31 performs this function for Timer #3. The function of each bit of Control Register "X" can therefore be defined as shown in the remaining section of Table 2.

• CRX2

Control Register Bit 2 selects whether the binary information contained in the Counter Latches (and subsequently loaded into the counter) is to be treated as a single 16-bit word or two 8-bit bytes. In the single 16-bit Counter Mode (CRX2=0) the counter will decrement to zero after $N + 1$ enabled (\overline{G} ="Low") clock periods, where N is defined as the 16-bit number in the Counter Latches. With CRX2 = 1, a similar Time Out will occur after $(L + 1) \cdot (M + 1)$ enabled clock periods, where L and M , respectively, refer to the LSB and MSB bytes in the Counter Latches.

• CRX3 ~ CRX7

Control Register Bits 3, 4, and 5 are explained in detail in the Timer Operating Mode section. Bit 6 is an interrupt mask bit which will be explained more fully in conjunction with the Status Register, and bit 7 is used to enable the corresponding Timer Output. A summary of the control register programming modes is shown in Table 3.

■ STATUS REGISTER/INTERRUPT FLAGS

The HD6340 has an internal Read-Only Status Register which contains four Interrupt Flags. (The remaining four bits of the register are not used, and default to "0" when being read.) Bits 0, 1, and 2 are assigned to Timers 1, 2, and 3, respectively, as individual flag bits, while Bit 7 is a Composite Interrupt Flag. This flag bit will be asserted if any of the individual flag bits is

Table 2 Control Register Bits

CONTROL REGISTER #1		CONTROL REGISTER #2		CONTROL REGISTER #3	
CR10	Internal Reset Bit	CR20	Control Register Address Bit	CR30	Timer #3 Clock Control
"0" All timers allowed to operate "1" All timers held in preset state		"0" CR #3 may be written "1" CR #1 may be written		"0" T3 Clock is not prescaled "1" T3 Clock is prescaled by ÷ 8	
CRX1*		Timer #X Clock Source			
"0"		TX uses external clock source on \overline{CX} input			
"1"		TX uses Enable clock			
CRX2		Timer #X Counting Mode Control			
"0"		TX configured for normal (16-bit) counting mode			
"1"		TX configured for dual 8-bit counting mode			
CRX3 CRX4 CRX5		Timer #X Counter Mode and Interrupt Control (See Table 3)			
CRX6		Timer #X Interrupt Enable			
"0"		Interrupt Flag masked on \overline{IRQ}			
"1"		Interrupt Flag enabled to \overline{IRQ}			
CRX7		Timer #X Counter Output Enable			
"0"		TX Output masked on output OX			
"1"		TX Output enabled on output OX			

* Control Register for Timer 1, 2, or 3, Bit 1.

set while Bit 6 of the corresponding Control Register is at a logic "1". The conditions for asserting the Composite Interrupt Flag bit can therefore be expressed as:

$$INT = I_1 \cdot CR16 + I_2 \cdot CR26 + I_3 \cdot CR36$$

where INT = Composite Interrupt Flag (Bit 7)

I₁ = Timer #1 Interrupt Flag (Bit 0)

I₂ = Timer #2 Interrupt Flag (Bit 1)

I₃ = Timer #3 Interrupt Flag (Bit 2)

STATUS REGISTER							
7	6	5	4	3	2	1	0
INT	/	/	/	/	I ₃	I ₂	I ₁

An interrupt flag is cleared by a Timer Reset condition, i.e., External RES = "Low" or Internal Reset Bit (CR10) = "1". It will also be cleared by a Read Timer Counter Command provided that the Status Register has previously been read while the interrupt flag was set. This condition on the Read Status Register - Read Timer Counter (RS-RT) sequence is designed to prevent missing interrupts which might occur after the status register is read, but prior to reading the Timer Counter.

An Individual Interrupt Flag is also cleared by a Write Timer Latches (W) command or a Counter Initialization (CI) sequence, provided that W or CI affects the Timer corresponding to the individual Interrupt Flag.

■ COUNTER LATCH INITIALIZATION

Each of the three independent timers consists of a 16-bit addressable counter and 16 bits of addressable latches. The counters are preset to the binary numbers stored in the latches. Counter initialization results in the transfer of the latch contents to the counter. See notes in Table 5 regarding the binary number N, L, or M placed into the Latches and their relationship to the output waveforms and counter Time-Outs.

Since the PTM data bus is 8-bits wide and the counters are 16-bits wide, a temporary register (MSB Buffer Register) is provided. This "write only" register is for the Most Significant

Byte of the desired latch data. Three addresses are provided for the MSB Buffer Register (as indicated in Table 1), but they all lead to the same Buffer. Data from the MSB Buffer will automatically be transferred into the Most Significant Byte of Timer #X when a Write Timer #X Latches Command is performed. So it can be seen that the HD6340 has been designed to allow transfer of two bytes of data into the counter latches provided that the MSB is transferred first.

In many applications, the source of the data will be as HMCS6800 MPU. It should be noted that the 16-bit store operations of the HMCS6800 microprocessors (STS and STX etc.) transfer data in the order required by the PTM. A Store Index Register Instruction, for example, results in the MSB of the X register being transferred to the selected address, then the LSB of the X register being written into the next higher location. Thus, either the index register or stack pointer may be transferred directly into a selected counter latch with a single instruction.

A logic "Low" at the \overline{RES} input also initializes the counter latches. In this case, all latches will assume a maximum count of (65,536)₁₀. It is important to note that an Internal Reset (Bit 0 of Control Register 1 Set) has no effect on the counter latches.

■ COUNTER INITIALIZATION

Counter Initialization is defined as the transfer of data from the latches to the counter with subsequent clearing of the Individual Interrupt Flag associated with the counter. Counter Initialization always occurs when a reset condition (RES = "Low" or CR10 = "1") is recognized. It can also occur - depending on Timer Mode - with a Write Timer Latches command or recognition of a negative transition of the Gate input.

Counter recycling or re-initialization occurs when a negative transition of the clock input is recognized after the counter has reached an all-zero state. In this case, data is transferred from the Latches to the Counter.

■ TIMER OPERATING MODES

The HD6340 has been designed to operate effectively in a wide variety of applications. This is accomplished by using three bits of each control register (CRX3, CRX4, and CRX5) to

defined different operating modes of the Timers. These modes are divided into Wave Synthesis and Wave Measurement modes, and outlined in Table 4.

Table 4 Operating Modes

Control Register			Timer Operating Mode	
CRX3	CRX4	CRX5		
0	*	0	Continuous	Wave
0	*	1	Single-Shot	Synthesis
1	0	*	Frequency Comparison	Wave
1	1	*	Pulse Width Comparison	Measurement

* Defines Additional Timer Functions.

One of the WAVE SYNTHESIS modes is the Continuous Operating mode, which is useful for cyclic wave generation.

Either symmetrical or variable duty-cycle waves can be generated in this mode. The other wave synthesis mode, the Single-Shot mode, is similar in use to the Continuous operating mode, however, a single pulse is generated, with a programmable preset width.

The WAVE MEASUREMENT modes include the Frequency Comparison and Pulse Width Comparison modes which are used to measure cyclic and singular pulse widths, respectively.

In addition to the four timer modes in Table 4, the remaining control register bit is used to modify counter initialization and enabling or interrupt conditions.

■ WAVE SYNTHESIS MODES

● Continuous Operating Mode (Table 5)

The continuous mode will synthesize a continuous wave with

Table 3 Control Register Programming

	Register 1	Register 2	Register 3																
<table border="1"> <tr><td>7</td><td>6</td><td>5</td><td>4</td><td>3</td><td>2</td><td>1</td><td>0</td></tr> <tr><td>X</td><td>X</td><td>X</td><td>X</td><td>X</td><td>X</td><td>X</td><td>↓</td></tr> </table>	7	6	5	4	3	2	1	0	X	X	X	X	X	X	X	↓	"0" All Timers Operate "1" All Timers Preset	Reg #3 May Be Written Reg #1 May Be Written	T3 Clk ÷ 1 T3 Clk ÷ 8
7	6	5	4	3	2	1	0												
X	X	X	X	X	X	X	↓												
<table border="1"> <tr><td>7</td><td>6</td><td>5</td><td>4</td><td>3</td><td>2</td><td>1</td><td>0</td></tr> <tr><td>X</td><td>X</td><td>X</td><td>X</td><td>X</td><td>X</td><td>↓</td><td>X</td></tr> </table>	7	6	5	4	3	2	1	0	X	X	X	X	X	X	↓	X	"0" External Clock (CX Input) "1" Internal Clock (Enable)		
7	6	5	4	3	2	1	0												
X	X	X	X	X	X	↓	X												
<table border="1"> <tr><td>7</td><td>6</td><td>5</td><td>4</td><td>3</td><td>2</td><td>1</td><td>0</td></tr> <tr><td>X</td><td>X</td><td>X</td><td>X</td><td>X</td><td>↓</td><td>X</td><td>X</td></tr> </table>	7	6	5	4	3	2	1	0	X	X	X	X	X	↓	X	X	"0" Normal (16-Bit) Count Mode "1" Dual 8-Bit Count Mode		
7	6	5	4	3	2	1	0												
X	X	X	X	X	↓	X	X												
<table border="1"> <tr><td>7</td><td>6</td><td>5</td><td>4</td><td>3</td><td>2</td><td>1</td><td>0</td></tr> <tr><td>X</td><td>X</td><td>0</td><td>0</td><td>0</td><td>X</td><td>X</td><td>X</td></tr> </table>	7	6	5	4	3	2	1	0	X	X	0	0	0	X	X	X	Continuous Operating Mode: $\overline{\text{Gate}} \downarrow$ or Write to Latches or Reset Causes Counter Initialization		
7	6	5	4	3	2	1	0												
X	X	0	0	0	X	X	X												
<table border="1"> <tr><td>7</td><td>6</td><td>5</td><td>4</td><td>3</td><td>2</td><td>1</td><td>0</td></tr> <tr><td>X</td><td>X</td><td>0</td><td>0</td><td>1</td><td>X</td><td>X</td><td>X</td></tr> </table>	7	6	5	4	3	2	1	0	X	X	0	0	1	X	X	X	Frequency Comparison Mode: Interrupt if $\overline{\text{Gate}} \downarrow$ is < Counter Time Out		
7	6	5	4	3	2	1	0												
X	X	0	0	1	X	X	X												
<table border="1"> <tr><td>7</td><td>6</td><td>5</td><td>4</td><td>3</td><td>2</td><td>1</td><td>0</td></tr> <tr><td>X</td><td>X</td><td>0</td><td>1</td><td>0</td><td>X</td><td>X</td><td>X</td></tr> </table>	7	6	5	4	3	2	1	0	X	X	0	1	0	X	X	X	Continuous Operating Mode: $\overline{\text{Gate}} \downarrow$ or Reset Causes Counter Initialization		
7	6	5	4	3	2	1	0												
X	X	0	1	0	X	X	X												
<table border="1"> <tr><td>7</td><td>6</td><td>5</td><td>4</td><td>3</td><td>2</td><td>1</td><td>0</td></tr> <tr><td>X</td><td>X</td><td>0</td><td>1</td><td>1</td><td>X</td><td>X</td><td>X</td></tr> </table>	7	6	5	4	3	2	1	0	X	X	0	1	1	X	X	X	Pulse Width Comparison Mode: Interrupt if $\overline{\text{Gate}} \downarrow$ is < Counter Time Out		
7	6	5	4	3	2	1	0												
X	X	0	1	1	X	X	X												
<table border="1"> <tr><td>7</td><td>6</td><td>5</td><td>4</td><td>3</td><td>2</td><td>1</td><td>0</td></tr> <tr><td>1</td><td>X</td><td>1</td><td>0</td><td>0</td><td>X</td><td>X</td><td>X</td></tr> </table>	7	6	5	4	3	2	1	0	1	X	1	0	0	X	X	X	Single Shot Mode: $\overline{\text{Gate}} \downarrow$ or Write to Latches or Reset Causes Counter Initialization		
7	6	5	4	3	2	1	0												
1	X	1	0	0	X	X	X												
<table border="1"> <tr><td>7</td><td>6</td><td>5</td><td>4</td><td>3</td><td>2</td><td>1</td><td>0</td></tr> <tr><td>X</td><td>X</td><td>1</td><td>0</td><td>1</td><td>X</td><td>X</td><td>X</td></tr> </table>	7	6	5	4	3	2	1	0	X	X	1	0	1	X	X	X	Frequency Comparison Mode: Interrupt If $\overline{\text{Gate}} \downarrow$ is > Counter Time Out		
7	6	5	4	3	2	1	0												
X	X	1	0	1	X	X	X												
<table border="1"> <tr><td>7</td><td>6</td><td>5</td><td>4</td><td>3</td><td>2</td><td>1</td><td>0</td></tr> <tr><td>1</td><td>X</td><td>1</td><td>1</td><td>0</td><td>X</td><td>X</td><td>X</td></tr> </table>	7	6	5	4	3	2	1	0	1	X	1	1	0	X	X	X	Single Shot Mode: $\overline{\text{Gate}} \downarrow$ or Reset Causes Counter Initialization		
7	6	5	4	3	2	1	0												
1	X	1	1	0	X	X	X												
<table border="1"> <tr><td>7</td><td>6</td><td>5</td><td>4</td><td>3</td><td>2</td><td>1</td><td>0</td></tr> <tr><td>X</td><td>X</td><td>1</td><td>1</td><td>1</td><td>X</td><td>X</td><td>X</td></tr> </table>	7	6	5	4	3	2	1	0	X	X	1	1	1	X	X	X	Pulse Width Comparison Mode: Interrupt If $\overline{\text{Gate}} \downarrow$ is > Counter Time Out		
7	6	5	4	3	2	1	0												
X	X	1	1	1	X	X	X												
<table border="1"> <tr><td>7</td><td>6</td><td>5</td><td>4</td><td>3</td><td>2</td><td>1</td><td>0</td></tr> <tr><td>X</td><td>↓</td><td>X</td><td>X</td><td>X</td><td>X</td><td>X</td><td>X</td></tr> </table>	7	6	5	4	3	2	1	0	X	↓	X	X	X	X	X	X	"0" Interrupt Flag Masked ($\overline{\text{IRQ}}$) "1" Interrupt Flag Enabled ($\overline{\text{IRQ}}$)		
7	6	5	4	3	2	1	0												
X	↓	X	X	X	X	X	X												
<table border="1"> <tr><td>7</td><td>6</td><td>5</td><td>4</td><td>3</td><td>2</td><td>1</td><td>0</td></tr> <tr><td>↓</td><td>X</td><td>X</td><td>X</td><td>X</td><td>X</td><td>X</td><td>X</td></tr> </table>	7	6	5	4	3	2	1	0	↓	X	X	X	X	X	X	X	"0" Timer Output Masked "1" Timer Output Enable		
7	6	5	4	3	2	1	0												
↓	X	X	X	X	X	X	X												

(NOTE) Reset is Hardware or Software Reset ($\overline{\text{RES}}$ = "Low" or CR10 = "1").

a period proportional to the preset number in the particular timer latches.

Any of the timers in the PTM may be programmed to operate in a continuous mode by writing "0"s into bits 3 and 5 of the corresponding control register. Assuming that the timer output is enabled (CRX7 = "1"), either a square wave or a variable duty cycle waveform will be generated at the Timer Output, OX. The type of output is selected via Control Register Bit 2.

Either a Timer Reset (CR10 = "1" or External \overline{RES} =

"Low") condition or internal recognition of a negative transition of the Gate input results in Counter Initialization. A Write Timer Latches command can be selected as a Counter Initialization signal by clearing CRX4.

The counter is enabled by an absence of a Timer Reset condition and a "Low" level at the Gate input. In the 16-bit mode, the counter will decrement on the first clock cycle during or after the counter initialization cycle. It continues to decrement on each clock signal so long as \overline{G} remains "Low" and no reset condition exists. A Counter Time Out (the first clock after all

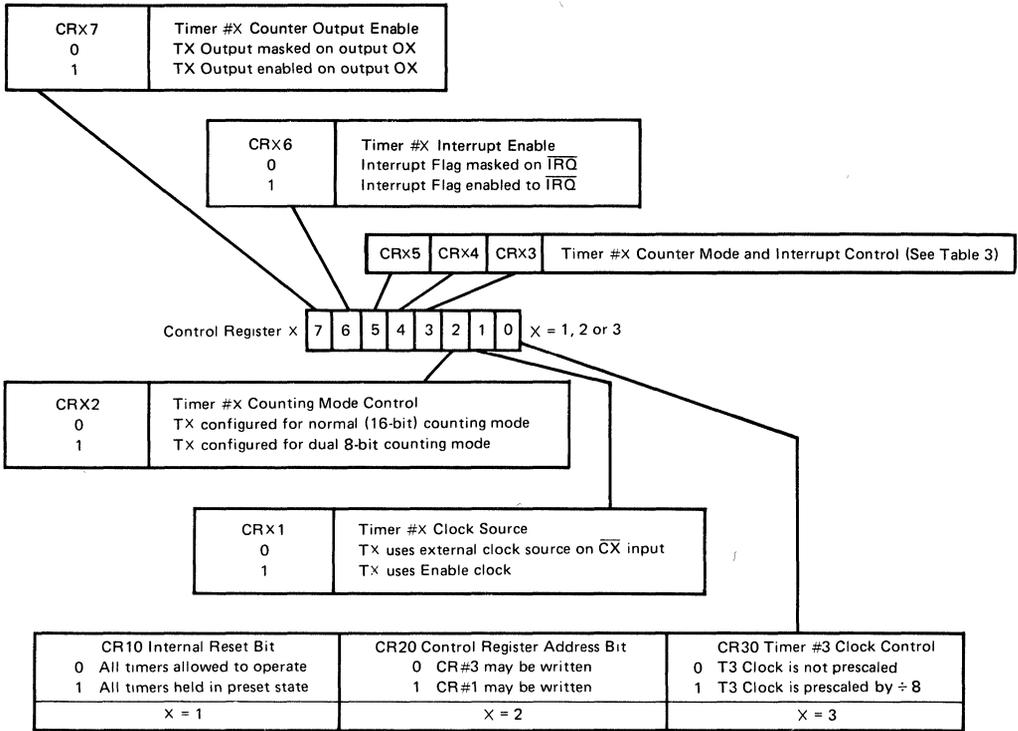
Table 5 Continuous Operating Modes

CONTINUOUS MODE (CRX3 = "0", CRX5 = "0")			
Control Register		Initialization/Output Waveforms	
CRX2	CRX4	Counter Initialization	*Timer Output (OX) (CRX7 = "1")
0	0	$\overline{G} \downarrow + W + R$	
0	1	$\overline{G} \downarrow + R$	
1	0	$\overline{G} \downarrow + W + R$	
1	1	$\overline{G} \downarrow + R$	

$\overline{G} \downarrow$ = Negative transition of \overline{Gate} input.
 W = Write Timer Latches Command.
 R = Timer Reset (CR10 = "1" or External \overline{RES} = "Low")
 N = 16-Bit Number in Counter Latch.
 L = 8-Bit Number in LSB Counter Latch.
 M = 8-Bit Number in MSB Counter Latch.
 T = Clock Input Negative Transitions to Counter.
 t_0 = Counter Initialization Cycle.
 TO = Counter Time Out (All Zero Condition).

* All time intervals shown above assume the \overline{Gate} (\overline{G}) and \overline{Clock} (\overline{C}) signals are synchronized to Enable (System ϕ_2) with the specified setup and hold time requirements.

Control Register Bits



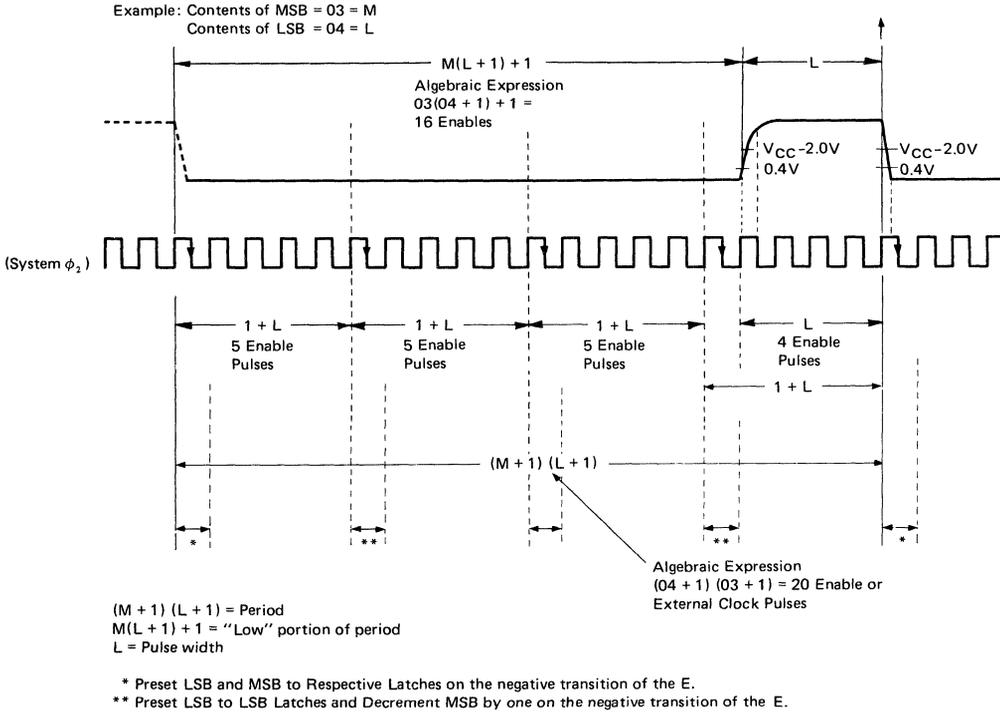


Figure 9 Timer Output Waveform Example
(Continuous Dual 8-Bit Mode using Internal Enable)

counter bits = "0") results in the Individual Interrupt Flag being set and re-initialization of the counter.

In the dual 8-bit mode (CRX2 = "1") [Refer to the example in Fig. 9] the MSB decrements once for every full countdown of the LSB + 1. When the LSB = "0", the MSB is unchanged; on the next clock pulse the LSB is reset to the count in the LSB Latches and the MSB is decremented by 1 (one). The output, if enabled, remains "Low" during and after initialization and will remain "Low" until the counter MSB is all "0"s. The output will go "High" at the beginning of the next clock pulse. The output remains "High" until both the LSB and MSB of the counter are all "0"s. At the beginning of the next clock pulse the defined Time Out (TO) will occur and the output will go "Low". In the Dual 8-bit mode the period of the output of the example in Fig. 9 would span 20 clock pulses as opposed to the 1546 clock pulses using the Normal 16-bit mode.

A special time-out condition exists for the dual 8-bit mode (CRX2 = "1") if L = "0". In this case, the counter will revert to a mode similar to the single 16-bit mode, except Time Out occurs after M+1 clock pulses. The output, if enabled, goes "Low" during the Counter Initialization cycle and reverses state at each Time Out. The counter remains cyclical (is re-initialized at each Time Out) and the Individual Interrupt Flag is set when Time Out occurs. If M = L = "0", the internal counters do not change, but the output toggles at a rate of 1/2 the clock frequency.

The discussion of the Continuous Mode has assumed that the

application requires an output signal. It should be noted that the Timer operates in the same manner with the output disabled (CRX7 = "0"). A Read Timer Counter command is valid regardless of the state of CRX7.

● **Single-Shot Timer Mode**

This mode is identical to the Continuous Mode with three exceptions. The first of these is obvious from the name – the output returns to a "Low" level after the initial Time Out and remains "Low" until another Counter Initialization cycle occurs. The waveforms available are shown in Table 6.

As indicated in Table 6, the internal counting mechanism remains cyclical in the Single-Shot Mode. Each Time Out of the counter results in the setting of an Individual Interrupt Flag and re-initialization of the counter.

The second major difference between the Single-Shot and Continuous modes is that the internal counter enable is not dependent on the Gate input level remaining in the "Low" state for the Single-Shot mode.

Another special condition is introduced in the Single-Shot mode. If L = M = "0" (Dual 8-bit) or N = "0" (Single 16-bit), the output goes "Low" on the first clock received during or after Counter Initialization. The output remains "Low" until the Operating Mode is changed or nonzero data is written into the Counter Latches. Time Outs continue to occur at the end of each clock period.

The three differences between Single-Shot and Continuous Timer Modes can be summarized as attributes of the Single-Shot

mode:

1. Output is enabled for only one pulse until it is reinitialized.

2. Counter Enable is independent of $\overline{\text{Gate}}$.
 3. $L = M = "0"$ or $N = "0"$ disables output.
- Aside from these differences, the two modes are identical.

Table 6 Single-Shot Operating Modes

Single-Shot Mode (CRX3 = "0", CRX7 = "1", CRX5 = "1")			
Control Register		Initialization/Output Waveforms	
CRX2	CRX4	Counter Initialization	Timer Output (OX)
0	0	$\overline{\text{G}}_1 + \text{W} + \text{R}$	
0	1	$\overline{\text{G}}_1 + \text{R}$	
1	0	$\overline{\text{G}}_1 + \text{W} + \text{R}$	
1	1	$\overline{\text{G}}_1 + \text{R}$	

Symbols are as defined in Table 5.

■ WAVE MEASUREMENT MODES

The Wave Measurement Modes are the Frequency (period) Measurement and Pulse Width Comparison Modes, and are provided for those applications which require more flexibility of interrupt generation and Counter Initialization. Individual Interrupt Flags are set in these modes as a function of both Counter Time Out and transitions of the $\overline{\text{Gate}}$ input. Counter Initialization is also affected by Interrupt Flag status.

A timer's output is normally not used in a Wave Measurement mode, but it is defined. If the output is enabled, it will

operate as follows. During the period between reinitialization of the timer and the first Time Out, the output will be a logical zero. If the first Time Out is completed (regardless of its method of generation), the output will go "High". If further TO's occur, the output will change state at each completion of a Time-Out.

The counter does operate in either Single 16-bit or Dual 8-bit modes as programmed by CRX2. Other features of the Wave Measurement Modes are outlined in Table 7.

Table 7 Wave Measurement Modes

CRX3 = "1"			
CRX4	CRX5	Application	Condition for Setting Individual Interrupt Flag
0	0	Frequency Comparison	Interrupt Generated if $\overline{\text{Gate}}$ Input Period (1/F) is less than Counter Time Out (TO)
0	1	Frequency Comparison	Interrupt Generated if $\overline{\text{Gate}}$ Input Period (1/F) is greater than Counter Time Out (TO)
1	0	Pulse Width Comparison	Interrupt Generated if $\overline{\text{Gate}}$ Input "Down Time" is less than Counter Time Out (TO)
1	1	Pulse Width Comparison	Interrupt Generated if $\overline{\text{Gate}}$ Input "Down Time" is greater than Counter Time Out (TO)

● Frequency Comparison or Period Measurement Mode (CRX3 = "1", CRX4 = "0")

The Frequency Comparison Mode with CRX5 = "1" is straightforward. If Time Out occurs prior to the first negative transition of the $\overline{\text{Gate}}$ input after a Counter Initialization cycle, an Individual Interrupt Flag is set. The counter is disabled, and a Counter Initialization cycle cannot begin until the interrupt flag is cleared and a negative transition on $\overline{\text{G}}$ is detected.

If CRX5 = "0", as shown in Table 7 and Table 8, an interrupt is generated if $\overline{\text{Gate}}$ input returns "Low" prior to a Time Out. If Counter Time-Out occurs first, the counter is recycled and continues to decrement. A bit is set within the timer on the initial Time Out which precludes further individual interrupt generation until a new Counter Initialization cycle has been completed. When this internal bit is set, a negative transition of the $\overline{\text{Gate}}$ input starts a new Counter Initialization cycle. (The

condition of $\overline{\text{G}}_1 \cdot \overline{\text{T}} \cdot \text{TO}$ is satisfied, since a Time Out has occurred and no individual Interrupt has been generated.)

Any of the timers within the PTM may be programmed to compare the period of a pulse (giving the frequency after calculations) at the Gate input with the time period requested for Counter Time-Out. A negative transition of the Gate input enables the counter and starts a Counter Initialization cycle — provided that other conditions as noted in Table 8 are satisfied. The counter decrements on each clock signal recognized during or after Counter Initialization until an Interrupt is generated, a Write Timer Latches command is issued, or a Timer Reset condition occurs. It can be seen from Table 8 that an interrupt condition will be generated if CRX5 = "0" and the period of the pulse (single pulse or measured separately repetitive pulses) at the Gate input is less than the Counter Time Out period. If CRX5 = "1", an interrupt is generated if the reverse is true.

Assume now with $\overline{CRX5} = "1"$ that a Counter Initialization has occurred and that the \overline{Gate} input has returned "Low" prior to Counter Time Out. Since there is no Individual Interrupt Flag generated, this automatically starts a new Counter Initialization Cycle. The process will continue with frequency comparison being performed on each \overline{Gate} input cycle until the mode is changed, or a cycle is determined to be above the predetermined limit.

- **Pulse Width Comparison Mode (CRX3 = "1", CRX4 = "1")**
This mode is similar to the Frequency Comparison Mode except for a positive, rather than negative, transition of the \overline{Gate}

input terminates the count. With $\overline{CRX5} = "0"$, an Individual Interrupt Flag will be generated if the "Low" level pulse applied to the \overline{Gate} input is less than the time period required for Counter Time Out. With $\overline{CRX5} = "1"$, the interrupt is generated when the reverse condition is true.

As can be seen in Table 9, a positive transition of the \overline{Gate} input disables the counter. With $\overline{CRX5} = "0"$, it is therefore possible to directly obtain the width of any pulse causing an interrupt. Similar data for other Time Interval Modes and conditions can be obtained, if two sections of the PTM are dedicated to the purpose.

Table 8 Frequency Comparison Mode

CRX3 = "1", CRX4 = "0"				
Control Reg Bit 5 (CRX5)	Counter Initialization	Counter Enable Flip-Flop Set (CE)	Counter Enable Flip-Flop Reset (CE)	Interrupt Flag Set (I)
0	$\overline{G}\downarrow \cdot \overline{T} \cdot (\overline{CE} + TO) + R$	$\overline{G}\downarrow \cdot \overline{W} \cdot \overline{R} \cdot \overline{T}$	W+R+I	$\overline{G}\downarrow$ Before TO
1	$\overline{G}\downarrow \cdot \overline{T} + R$	$\overline{G}\downarrow \cdot \overline{W} \cdot \overline{R} \cdot \overline{T}$	W+R+I	TO Before $\overline{G}\downarrow$

I represents the interrupt for a given timer.

Table 9 Pulse Width Comparison Mode

CRX3 = "1", CRX4 = "1"				
Control Reg Bit 5 (CRX5)	Counter Initialization	Counter Enable Flip-Flop Set (CE)	Counter Enable Flip-Flop Reset (CE)	Interrupt Flag Set (I)
0	$\overline{G}\downarrow \cdot \overline{T} + R$	$\overline{G}\downarrow \cdot \overline{W} \cdot \overline{R} \cdot \overline{T}$	W+R+I+G	$\overline{G}\uparrow$ Before TO
1	$\overline{G}\downarrow \cdot \overline{T} + R$	$\overline{G}\downarrow \cdot \overline{W} \cdot \overline{R} \cdot \overline{T}$	W+R+I+G	TO Before $\overline{G}\uparrow$

G = Level sensitive recognition of \overline{Gate} input.

■ **NOTE FOR USE**

Input signal, which is not necessary for user's application, should be used fixed to "High" or "Low" level. This is applicable to the following signal pins.

- $\overline{C}_1, \overline{C}_2, \overline{C}_3, \overline{G}_1, \overline{G}_2, \overline{G}_3$

HD6843, HD68A43 FDC (Floppy Disk Controller)

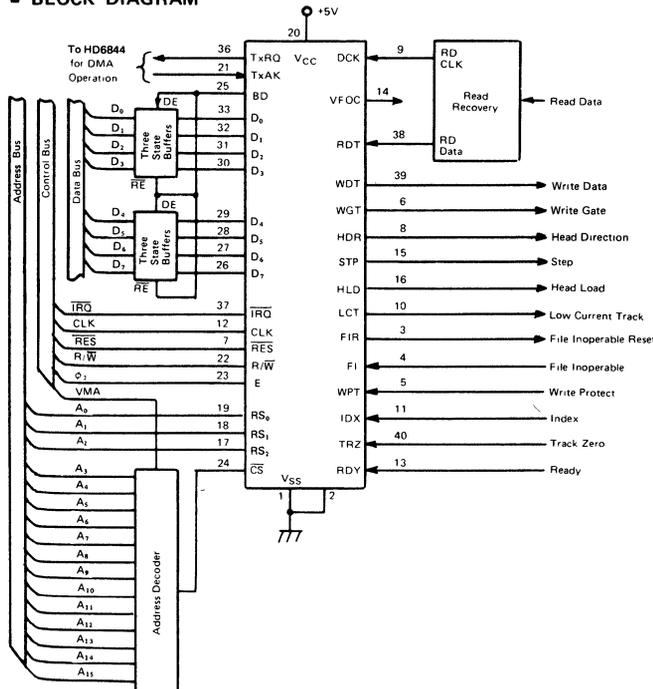
The HD6843 Floppy Disk Controller performs the complex MPU/Floppy interface function. The FDC was designed to optimize the balance between the "Hardware/Software" in order to achieve integration of all key functions and maintain flexibility.

The FDC can interface a wide range of drives with a minimum of external hardware. Multiple drives can be controlled with the addition of external multiplexing rather than additional FDC's.

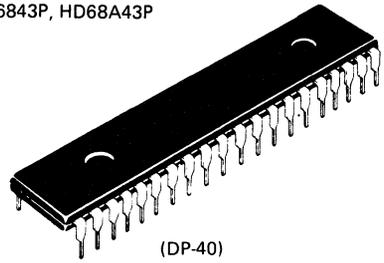
■ FEATURES

- Format compatible with IBM3740
- User Programmable read/write format
- Ten powerful macro-commands
- Macro End Interrupt allows parallel processing of MPU and FDC
- Controls multiple Floppies with external multiplexing
- Direct interface with HMCS6800
- Programmable seek and settling times enable operation with a wide range of Floppy drives
- Offers both Programmed Controlled I/O (PCIO) and DMA data transfer mode
- Free-Format read or write
- Single 5-volt power supply
- All registers directly accessible
- Compatible with MC6843

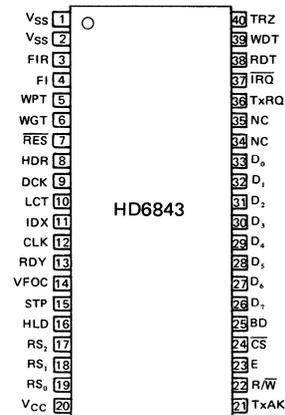
■ BLOCK DIAGRAM



HD6843P, HD68A43P



■ PIN ARRANGEMENT



(Top View)

■ ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Value	Unit
Supply Voltage	V_{CC}^*	-0.3 ~ +7.0	V
Input Voltage	V_{in}^*	-0.3 ~ +7.0	V
Operating Temperature	T_{opr}	0 ~ +75	°C
Storage Temperature	T_{stg}	-55 ~ +150	°C

* With respect to V_{SS} (SYSTEM GND)

(NOTE) Permanent LSI damage may occur if maximum ratings are exceeded. Normal operation should be under recommended operating conditions. If these conditions are exceeded, it could affect reliability of LSI.

■ RECOMMENDED OPERATING CONDITIONS

Item	Symbol	min.	typ.	max.	Unit
Supply Voltage	V_{CC}^*	4.75	5.0	5.25	V
Input "High" Voltage	V_{IH}^*	2.0	—	V_{CC}	V
Input "Low" Voltage	V_{IL}^*	-0.3	—	0.8	V
Operating Temperature	T_{opr}	0	25	75	°C

* With respect to V_{SS} (SYSTEM GND)

■ ELECTRICAL CHARACTERISTICS

● DC CHARACTERISTICS ($V_{CC}=5V\pm 5\%$, $V_{SS}=0V$, $T_a = 0 \sim +75^\circ C$, unless otherwise noted.)

Item	Symbol	Test Condition	min.	typ.*	max.	Unit
Input "High" Voltage	V_{IH}		2.0	—	V_{CC}	V
Input "Low" Voltage	V_{IL}		-0.3	—	0.8	V
Input Leakage Current	I_{in}	$V_{in}=0\sim 5.25V$	—	1.0	2.5	μA
Output "High" Voltage	V_{OH}	$I_{OH}=-205\mu A (D_0\sim D_7)$ $I_{OH}=-100\mu A (Others)$	2.4	—	—	V
Output "Low" Voltage	V_{OL}	$I_{OL}=3.2mA (IR\bar{Q})$ $I_{OL}=1.6mA (Others)$	—	—	0.4	V
Three-state (off-state) Leakage Current	I_{TSI}	$V_{in}=0.4\sim 2.4V$	—	2.0	10	μA
Output Leakage (off-state) Current (IR \bar{Q})	I_{LOH}	$V_{OH}=2.4V$	—	1.0	10	μA
Power Dissipation	P_D		—	600	1000	mW
Input Capacitance	$D_0\sim D_7$	$V_{in}=0V, T_a=25^\circ C,$ $f=1\text{ MHz}$	—	—	12.5	pF
	Other inputs		—	—	10	pF
Output Capacitance	C_{out}	$V_{in}=0V, T_a=25^\circ C,$ $f=1\text{ MHz}$	—	—	10	pF

* $V_{CC} = 5V, T_a = 25^\circ C$

● AC CHARACTERISTICS (V_{CC}=5V±5%, V_{SS}=0V, T_a = 0 ~ +75°C, unless otherwise noted.)

Item	Symbol	Test Condition	HD6843			HD68A43			Unit
			min.	typ.	max.	min.	typ.	max.	
CLK Cycle Time	t _{cycC}	Figure 1	—	1.0	—	—	1.0	—	μs
CLK Pulse Width, "High"	PW _{HC}	Figure 1	0.4	—	—	0.4	—	—	μs
CLK Pulse Width, "Low"	PW _{LC}	Figure 1	0.35	—	—	0.35	—	—	μs
Rise and Fall Time of CLK	t _{Cr} , t _{Cf}	Figure 1	—	—	25	—	—	25	ns
DCK Cycle Time	t _{cycD}	Figure 2	2.6	4.0	—	2.6	4.0	—	μs
DCK Pulse Width, "High"	PW _{HD}	Figure 2	1.3	1.95	—	1.3	1.95	—	μs
DCK Pulse Width, "Low"	PW _{LD}	Figure 2	1.3	1.95	—	1.3	1.95	—	μs
Rise and Fall Time of DCK	t _{Dr} , t _{Df}	Figure 2	—	—	25	—	—	25	ns
RDT Width, "High"	t _{RDH}	Figure 2	1.0	—	—	1.0	—	—	μs
RDT Width, "Low"	t _{RDL}	Figure 2	1.0	—	—	1.0	—	—	μs
RDT~DCK Delay Time 1	t _{RDD1}	Figure 2	0.15	—	1.70	0.15	—	1.70	μs
RDT~DCK Delay Time 2	t _{RDD2}	Figure 2	0.15	—	1.70	0.15	—	1.70	μs
IDX Pulse Width, "High"	PW _{IDX}	Figure 3	20.0	—	—	20.0	—	—	μs
FIR Delay Time	t _{FIRD}	Figure 4	—	—	450	—	—	450	ns
FIR Pulse Width, "High"	PW _{FIR}	Figure 4	200	—	—	200	—	—	ns
WDT Pulse Width, "High"	PW _{WD}	Figure 7	—	1.0	—	—	1.0	—	μs
WDT Cycle Time	t _{cycW}	Figure 7	—	2.0	—	—	2.0	—	μs
STP Pulse Width, "High"	PW _{STP}	Figure 5	—	32	—	—	32	—	μs
STP Cycle Time	t _{cycS} *	Figure 5	1	—	15	1	—	15	ms
HLD Delay Time (HLD~STP)	t _{HLD} *	Figure 5	1	—	15	1	—	15	ms
HDR Set Up Time	t _{HDRS}	Figure 5	0	—	—	0	—	—	ns
HDR Hold Time	t _{HDRH}	Figure 5	32	—	—	32	—	—	μs
TxAk Set Up Time	t _{AS3}	Figure 10, 11	140	—	—	140	—	—	ns
TxAk Hold Time	t _{AH3}	Figure 10, 11	10	—	—	10	—	—	ns
TxRQ Release Time	t _{TR}	Figure 10, 11	—	—	450	—	—	240	ns
IRQ Release Time	t _{IR}	Figure 6	—	—	1.2	—	—	1.2	μs

* Cycle Time of STP and HLD Delay Time change according to the program.

● BUS TIMING CHARACTERISTICS (V_{CC}=5V±5%, V_{SS}=0V, T_a = 0 ~ +75°C, unless otherwise noted.)

1 READ OPERATION SEQUENCE

Item	Symbol	Test Condition	HD6843			HD68A43			Unit
			min.	typ.	max.	min.	typ.	max.	
Enable Cycle Time	t _{cycE}	Figure 8, 10	1.0	—	—	0.666	—	—	μs
Enable Pulse Width, "High"	PW _{EH}	Figure 8, 10	0.4	—	—	0.23	—	—	μs
Enable Pulse Width, "Low"	PW _{EL}	Figure 8, 10	0.4	—	—	0.23	—	—	μs
Rise and Fall Time of Enable Input	t _{Er} , t _{Ef}	Figure 8, 10	—	—	25	—	—	25	ns
Address Set Up Time	t _{AS}	Figure 8, 10	140	—	—	140	—	—	ns
Data Delay Time	t _{DDR}	Figure 8, 10	—	—	225	—	—	200	ns
Data Access Time	t _{ACC}	Figure 8, 10	—	—	365	—	—	340	ns
Data Hold Time	t _H	Figure 8, 10	10	—	—	10	—	—	ns
Address Hold Time	t _{AH}	Figure 8, 10	10	—	—	10	—	—	ns
Bus Direction Delay Time	t _{DBD}	Figure 8, 10	—	—	400	—	—	400	ns

2 WRITE OPERATION SEQUENCE

Item	Symbol	Test Condition	HD6843			HD68A43			Unit
			min.	typ.	max.	min.	typ.	max.	
Enable Cycle Time	t_{cycE}	Figure 9, 11	1.0	—	—	0.666	—	—	μs
Enable Pulse Width, "High"	PW_{EH}	Figure 9, 11	0.4	—	—	0.23	—	—	μs
Enable Pulse Width, "Low"	PW_{EL}	Figure 9, 11	0.4	—	—	0.23	—	—	μs
Rise and Fall Time of Enable Input	t_{Er}, t_{Ef}	Figure 9, 11	—	—	25	—	—	25	ns
Address Set Up Time	t_{AS}	Figure 9, 11	140	—	—	140	—	—	ns
Data Set Up Time	t_{DSW}	Figure 9, 11	100	—	—	60	—	—	ns
Data Hold Time	t_H	Figure 9, 11	10	—	—	10	—	—	ns
Address Hold Time	t_{AH}	Figure 9, 11	10	—	—	10	—	—	ns
Bus Direction Delay Time	t_{DBD}	Figure 9, 11	—	—	400	—	—	400	ns

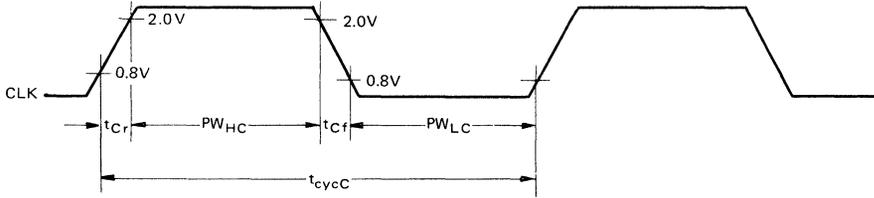


Figure 1 CLK Waveform

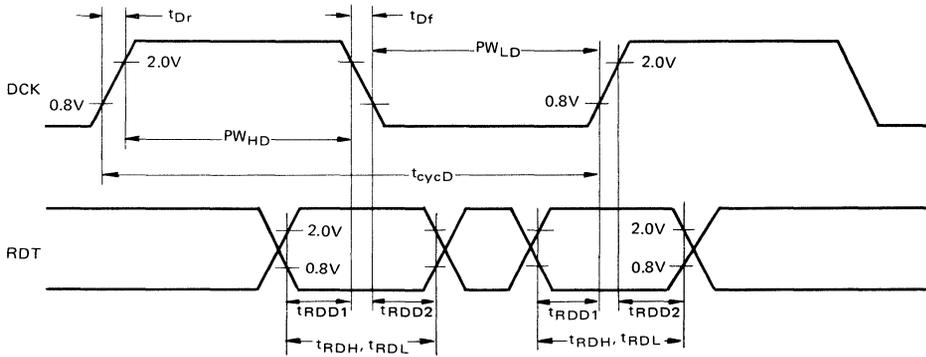


Figure 2 DCK, RDT Timing

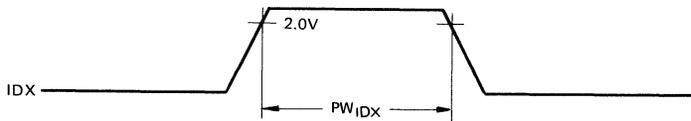


Figure 3 IDX Waveform

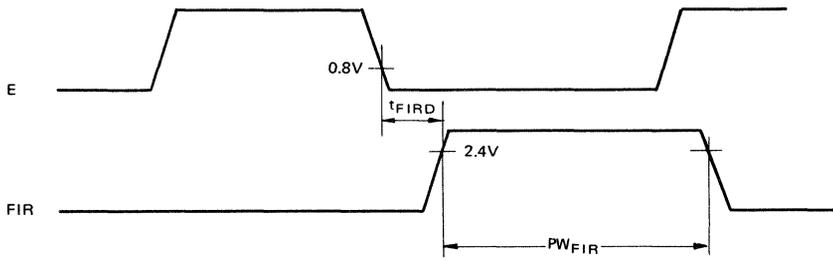


Figure 4 FIR Timing

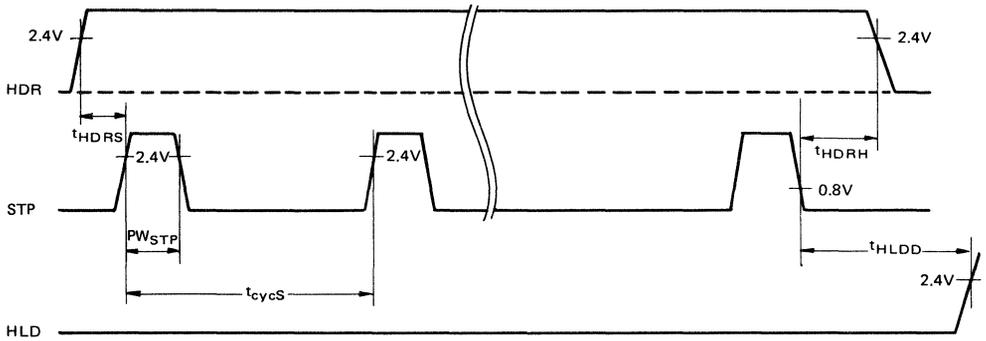


Figure 5 Seek Operation Sequence

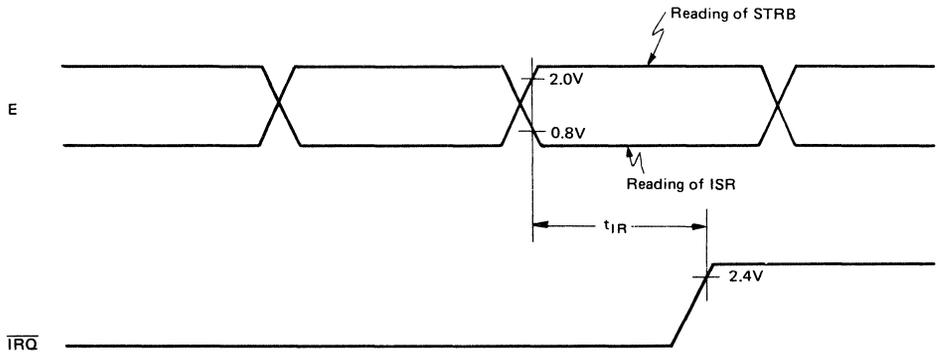


Figure 6 \overline{IRQ} Release Timing

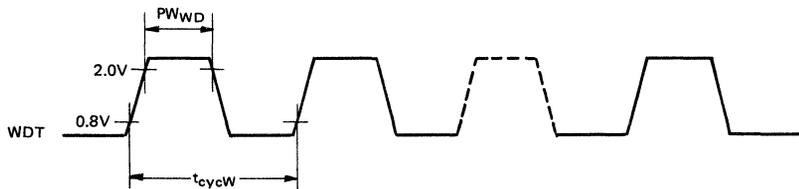


Figure 7 WDT Waveform

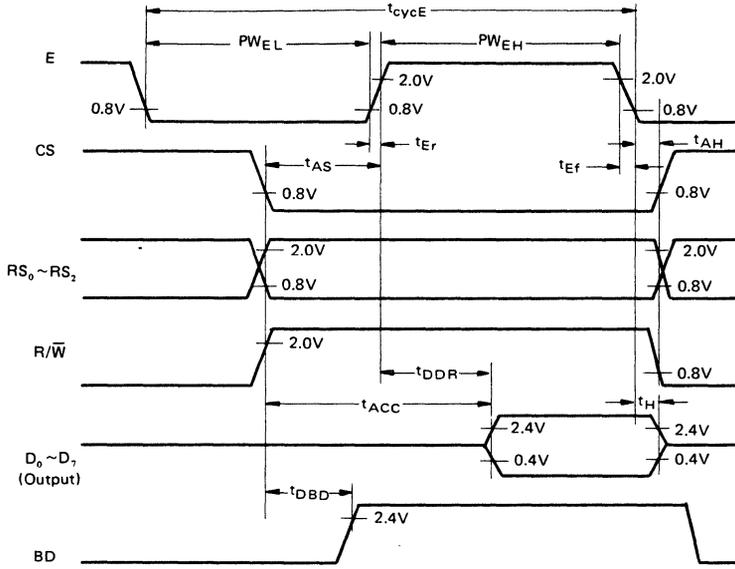


Figure 8 Read Timing

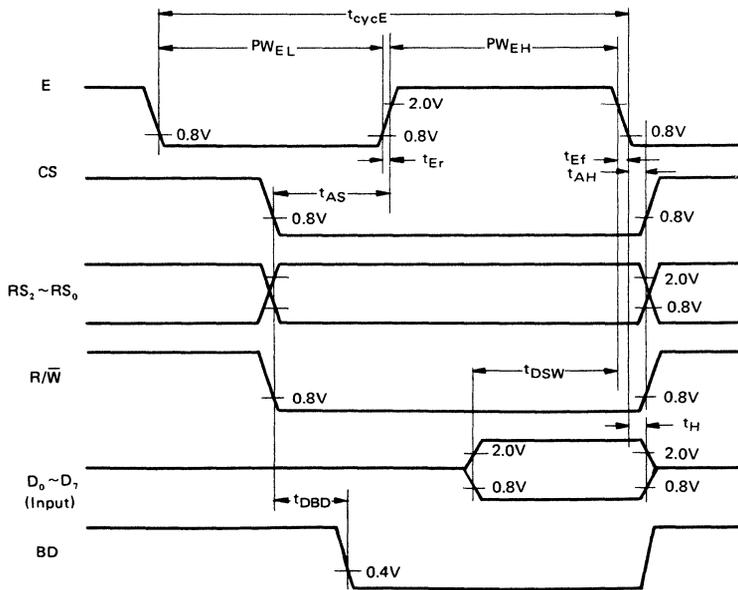


Figure 9 Write Timing

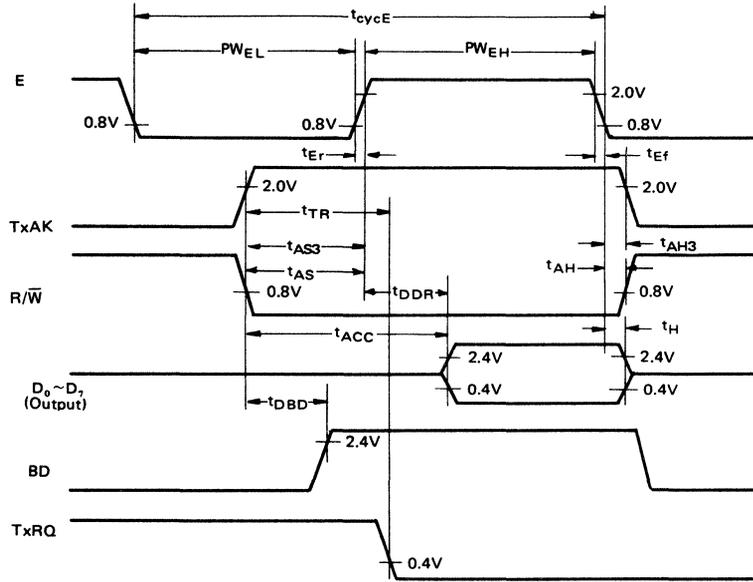


Figure 10 DMA Read Timing

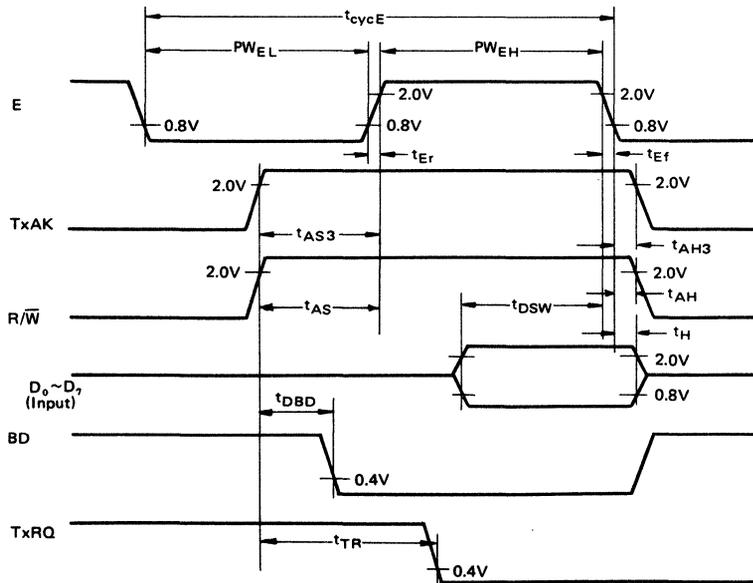
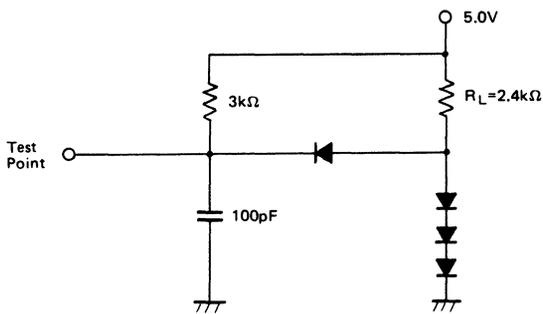
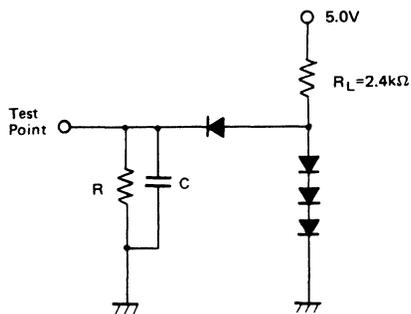


Figure 11 DMA Write Timing

LOAD A (Except \overline{IRQ})

LOAD B (\overline{IRQ})



R = 12kΩ, C = 130pF ($D_0 \sim D_7$)
 R = 24kΩ, C = 30 pF
 (Outputs except \overline{IRQ} , $D_0 \sim D_7$)
 All diodes are 1S2074 (H) or equivalent.

Figure 12 Load Circuit

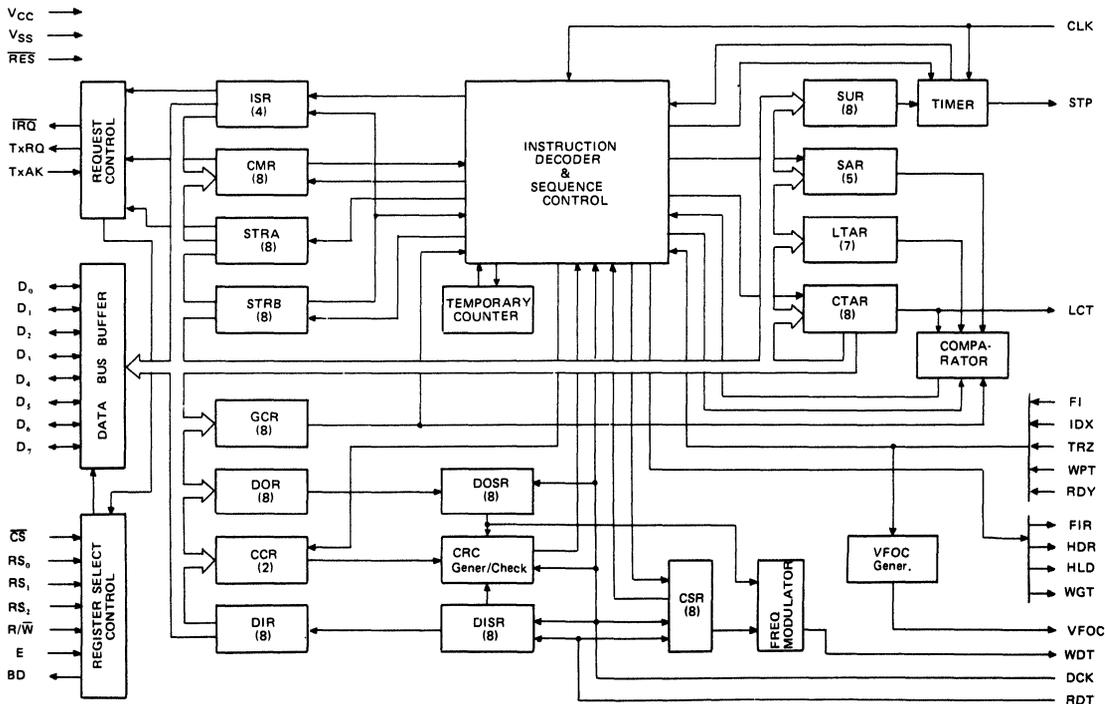


Figure 13 Block Diagram of the FDC

■ **GENERAL DESCRIPTION**

The HD6843 FDC consists of four primary sections; the Register, Serializing, Bus Interface, and Control sections. The following explanation of these sections can be followed in the block diagram of Figure 13.

● **Register Section**

The register section consists of twelve user accessible registers used for controlling a floppy disk drive. All twelve are connected by the internal data bus to allow the processor access to them.

Data Output Register (DOR)

The DOR is an 8-bit register which holds the data to be written onto the disk. The information is stored here by the bus interface.

Data Input Register (DIR)

The data words read from the disk are stored in the 8-bit DIR until read by the bus interface.

Current Track Address Register (CTAR)

CTAR is a 8-bit register containing the address of the track over which the R/W head is currently positioned.

Command Register (CMR)

The macro commands are written to the 8-bit CMR to begin their execution.

Interrupt Status Register (ISR)

The four bits of the ISR represent the four conditions that can cause an interrupt to occur.

Set-Up Register (SUR)

Variable Seek and Settling times are programmed by the SUR. Four bits are used to program the track to track seek time and four bits are used to program the head settling time for the floppy disk drive used with the FDC.

Status Register A (STRA)

The eight bits of STRA are used to indicate the state of the floppy disk interface.

Sector Address Register (SAR)

SAR contains the five bit sector address associated with the current data transfer.

Status Register B (STRB)

The eight error flags of STRB are used to signify error conditions detected by the FDC or generated by the floppy disk drive.

General Count Register (GCR)

The seven bits of GCR contain the destination track address when a SEK (seek) macro command is being executed. If a multi-sector Read or Write macro command is being executed, GCR contains the number of sectors to be read or written.

CRC Control Register (CCR)

The two bits of the CCR are used to enable the CRC and shift the CRC for the Free Format Commands.

Logical Track Address Register (LTAR)

The seven bit track address used for read and write

operations is stored in the LTAR by the bus interface.

● **Serializing Section**

The serializing section handles the serial-to-parallel and parallel-to-serial conversions for Read/Write operations as well as CRC generation/checking and the generation/detection of the clock pattern. The Data Output Shift Register (DOSR), Data Input Shift Register (DISR), CRC Generator/Checker, and Clock Shift Register (CSR) comprise the serializing section of the FDC.

● **Bus Interface**

The Bus Interface section provides the timing and control logic that allows the FDC to operate with the 6800 bus, and is comprised of the Data Buffers, Request Control, and the Register Select circuitry.

● **Control**

The internal timing and control signals which sequence the FDC are derived from the macro instructions by the control section.

■ **HD6843 PIN DESCRIPTION**

● **Power Pins**

V_{CC}: +5 volt (±5%) power input.

V_{SS}: Power Supply Ground.

● **Bus Pins**

Reset ($\overline{\text{RES}}$) Input

The $\overline{\text{RES}}$ input is used to initialize the FDC. When $\overline{\text{RES}}$ becomes "Low", the state of the outputs is defined by the table below:

Output	State of Output	Output	State of Output
FIR	"Low"	HLD	"Low"
WGT	"Low"	TxRQ	"Low"
HDR	"Low"	IRQ	"High"
STP	"Low"	WDT	"Low"

Registers which are affected by $\overline{\text{RES}}$ are shown in Table 7.

Interrupt Request ($\overline{\text{IRQ}}$) Output

The $\overline{\text{IRQ}}$ line is an open drain output that becomes a "Low" level (logic "0") when the FDC requests an interrupt. Interrupt requests are controlled by the interrupt enables in CMR (Command Register) with the function causing the interrupt shown in ISR (Interrupt Status Register).

Data Bus 0~Data Bus 7 (D₀~D₇) Bidirectional

The 8 bidirectional data lines allow the transfer of data between the FDC and the controlling system. The output buffers are three-state drivers that are enabled when the FDC is transferring data to the data bus.

Enable (E) Input

The E input to the FDC causes data transfers to occur between the FDC and the system controlling the FDC

(HMCS6800 MPU, DMA Controller, etc.) E must be a logic "1" ("High" level) for any transfer to be enabled on D₀~D₇. The E input is normally connected to system φ₂.

Chip Select (\overline{CS}) Input

The \overline{CS} input in conjunction with the E input, is used to enable data transfers on D₀~D₇. E must be a "High" level and \overline{CS} must be a "Low" level (logic "0") to enable the transfer. The TxAK input being a "High" level (logic "1") performs a similar function as \overline{CS} being a "Low" level.

Read/Write (R/\overline{W}) Input

The R/\overline{W} input is issued by the system controlling the FDC (HMCS6800 MPU, DMA Controller, etc.) to signify if a read or write operation is to be performed on the FDC. When TxAK is a "Low" level, R/\overline{W} is used in conjunction with \overline{CS} and RS₀~RS₂ to determine which register is accessed by the bus as shown in Table 1. When TxAK is a "High" level, R/\overline{W} is used to select either the DOR or DIR to the data bus (see description of TxAK input).

Register Select 0~Register Select 2 (RS₀~RS₂) Input

RS₀~RS₂, in conjunction with the R/\overline{W} input, are used to select one of the user accessible registers in the FDC as shown in Table 1.

Transfer Request (TxRQ) Output

TxRQ is used in the DMA mode to request a data transfer from the DMAC. TxRQ is a "High" level if the FDC is in the DMA mode (CMR bit 5 is set) when a data transfer request occurs (STRA bit 0 is set). It is reset to a "Low" level (logic "0") when TxAK becomes a "High" level (logic "1"). Data transfer errors will occur if TxAK does not reset TxRQ before the next data transfer is required.

Transfer Acknowledge (TxAK) Input

TxAK is generated by the system controlling the FDC (HMCS6800 MPU, DMA Controller, etc.) and is a response to a TxRQ issued by the FDC. A "High" level (logic "1") on TxAK

causes the FDC to neglect the state of RS₀~RS₂ causing the FDC to select the DOR (Data Output Register) or DIR (Data Input Register) to the data bus (D₀~D₇) as shown in Table 2. \overline{CS} = "0" and TxAK = "1" cannot be permitted at the same time.

Table 2 Register Selection for DMA Transfers

TxAK	RS ₀ ~RS ₂	\overline{CS}	R/\overline{W}	Register Selected
1	x	1	1	DOR
1	x	1	0	DIR

"1" "High", "0" "Low"

This mode of operation is normally used for DMA (Direct Memory Access) transfer with the FDC.

When TxAK is a "Low" level the registers are selected by \overline{CS} , R/\overline{W} and RS₀~RS₂ as shown in Table 1.

• **Bus Direction (BD) Output**

The BD output is provided to control external bidirectional buffers on the data bus (D₀~D₇) as shown in Figure 14. Its polarity is shown by Table 3.

Table 3 Bus Direction (BD) States

TxAK	\overline{CS}	BD
1	1	R/\overline{W}
0	1	0
0	0	R/\overline{W}

"1" "High", "0" "Low"

(Operation of BD as defined by this chart allows the FDC to function with the DMA Controller HD6844.)

Table 1 Address Codes for User Accessible Registers

TxAK	\overline{CS}	RS ₂	RS ₁	RS ₀	R/\overline{W}	Registers
0	0	0	0	0	0	DOR (Data Output Register)
					1	DIR (Data Input Register)
0	0	0	0	1	1/0	CTAR (Current Track Address Register)
					0	CMR (Command Register)
0	0	0	1	0	1	ISR (Interrupt Status Register)
					0	SUR (Set Up Register)
0	0	0	1	1	1	STRA (Status Register A)
					0	SAR (Sector Address Register)
0	0	1	0	0	1	STRB (Status Register B)
					0	GCR (General Count Register)
0	0	1	1	0	0	CCR (CRC Control Register)
0	0	1	1	1	0	LTAR (Logical Track Address Register)

"1" "High", "0" "Low"

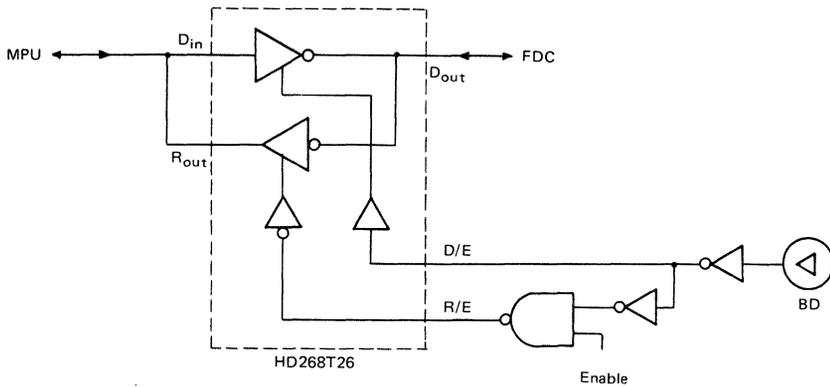


Figure 14 Bus Buffer Control

• I/O and Control Pins

Head Load (HLD) Output

HLD is used to notify the disk drive that the R/W head should be loaded (placed in contact with the media). When the FDC is ready for the head to load, HLD is a “High” level (logic “1”). A “Low” level (logic “0”) HLD indicates the head should be unloaded.

Step (STP) Output

The STP output, in conjunction with HDR, is used to control head movement. A 32 μ s wide positive (logic “1”) pulse is generated on STP, to move the R/W head one track in the direction defined by the HDR output. The period of the STP signal is programmable by the SUR (Set-Up Register). The number of pulses generated on STP is the difference between the contents of the CTAR (Current Track Address Register), and the GCR (General Count Register) which contains the track address to which the head is to be moved.

Head Direction (HDR) Output

The HDR signal controls the direction of head movement. A “High” level (logic “1”) signifies the head should step to the inside (toward the hub) of the disk. A “Low” level (logic “0”) indicates the direction of head movement should be to the outside of the disk.

Low Current Track (LCT) Output

The LCT signal is used to control the level of write current used by the disk drive. LCT is a “Low” level (logic “0”) when the write head is positioned over tracks 0~43. If it is over tracks 44~76, LCT is a “High” level (logic “1”). LCT is determined from the contents of the Current Track Address Register (CTAR).

Write Gate (WGT) Output

When a write operation is being performed, WGT is a logic “1” (“High” level). For a read operation, WGT is a “Low” level (logic “0”).

File Inoperable Reset (FIR) Output

FIR is an output from the FDC to the floppy disk drive to reset it from an inoperable status. If the FI input is a “High” level, a pulse, of which width almost equals to E pulse “Low” width, is generated on the FIR output whenever Status Register

B is read.

File Inoperable (FI) Input

FI is an input to the FDC from the drive. A “High” level indicates the drive is in an inoperable state. Its current state can be examined by reading bit 5 of Status Register B (STRB).

Track Zero (TRZ) Input

The TRZ input is reflected by bit 3 of STRA (Status Register A). The TRZ input must be a “High” level (logic “1”) when the R/W head of the drive is positioned over track zero. A logic “1” on this input inhibits step pulses during a Seek Track Zero command.

Index (IDX) Input

The index input is received from the floppy disk drive and is used to sense the index hole in the disk media. The IDX signal is used to initialize the internal FDC timing. The state of the IDX input is reflected by bit 6 of Status Register A (STRA). A “High” level (logic “1”) is to indicate the index hole is under the index sensor. The index input is used to count the number of disk revolutions while searching for the address ID field (see description of STRB bit 3).

Ready (RDY) Input

The ready input is received from the disk drive and can be read as bit 2 of STRA (Status Register A). A “High” level (logic “1”) indicates the drive is ready and allows the FDC to operate the drive.

Write Protect (WPT) Input

WPT is an input indicating when the media is Write Protected. A “High” level during an FDC write operation results in a Write Error (STRB bit 6) but the FDC continues to perform the write function. The state of the WPT input can be read by examining bit 4 of the Status Register A (STRA).

Clock (CLK) Input

The CLK input is used to generate various timing sequences internal to the FDC. The head settling, seek time, step pulse width and write data pulse width, etc., are generated from the CLK input signal. The CLK is 1 MHz frequency and the duty is 50%.

● Data Pins

Data Clock (DCK) Input

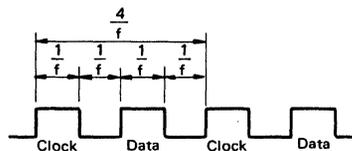
DCK is used to clock data from the drive into the FDC. It is generated from the read data received from the drive.

Read Data (RDT) Input

RDT is the serial data input from the drive. The data stream includes both the clock and data bits.

Write Data (WDT) Output

WDT is the double frequency modulated data output from the FDC. The time between clock bits is $4/f$ where f is the frequency of the clock input. The pulse width for both clock and data is $1/f$ (see Figure 15). For the normal clock frequency of 1 MHz the clock period is 4 μ s, the clock pulse width is 1 μ s and the data pulse width is 1 μ s. Figure 15 shows the relationship between the WDT output and the frequency of the CLK inputs.



f = Frequency of the CLK Input. To insure IBM3740 compatibility the clock frequency must be 1 MHz.

Figure 15 WDT Output Timing

■ **FORMAT**

The format used by the HD6843, shown in Figure 18, is compatible with the soft sector format of the IBM3740.

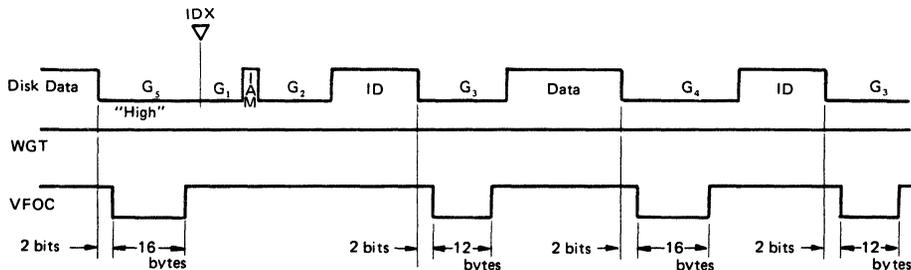
■ **MACRO COMMAND SET**

The macro command set shown in Table 4 is discussed in the following paragraphs.

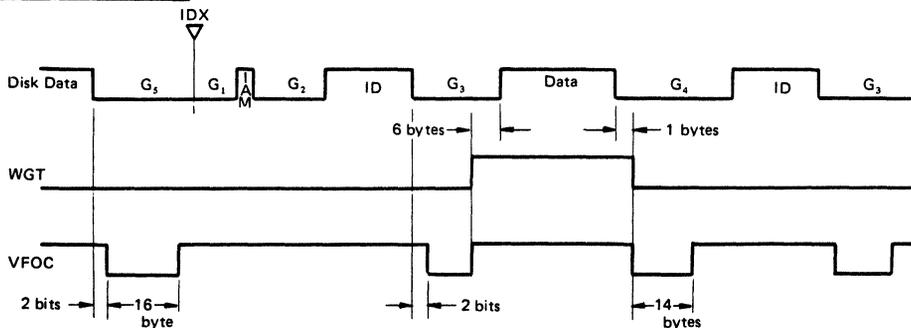
Variable Frequency Oscillator Control (VFOC) Output

VFOC is used as a sync signal during system diagnostics. Waveforms are shown in Figure 16.

SSR, RCR, MSR Command



SSW, SWD, MSW Command



In FFW Command, VFOC becomes "High" when WGT is at "High" level.
In FFR Command, VFOC remains "High".

Figure 16 Variable Frequency Oscillator Control Waveform (Relation Between WGT and VFOC)

SSW, SWD and MSW commands (Single Sector Write, Single Sector Write with Delet Data Mark, and Multi-Sector Write)

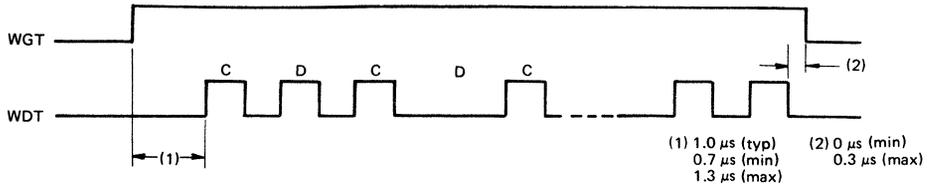


Figure 17 Write Data versus Write Gate Timing

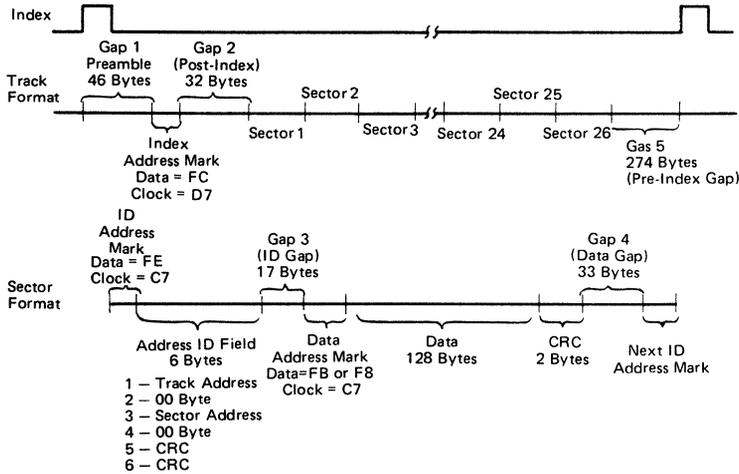


Figure 18 Soft Sector Format

Table 4 Macro Command Set

Macro Command			CMR Bits				Hex Code
			Bit 3	Bit 2	Bit 1	Bit 0	
1	STZ	Seek Track Zero	0	0	1	0	2
2	SEK	Seek	0	0	1	1	3
3	SSR	Single Sector Read	0	1	0	0	4
4	SSW	Single Sector Write	0	1	0	1	5
5	RCR	Read CRC	0	1	1	0	6
6	SWD	Single Sector Write with Delete Data Mark	0	1	1	1	7
7	MSW	Multi Sector Write	1	1	0	1	D
8	MSR	Multi Sector Read	1	1	0	0	C
9	FFW	Free Format Write	1	0	1	1	B
10	FFR	Free Format Read	1	0	1	0	A

• **Seek Track Zero (STZ)**

The STZ command causes the R/W head to be released from the surface of the disk (HLD is reset) and positioned above track 00. The FDC issues step pulses on the STP output until the TRZ input becomes a "High" level or until 82 pulses have been sent to the drive. When the TRZ input becomes "High", the step pulses are inhibited on the STP output but the FDC remains busy until all 82 have been generated internally.

If the TRZ input remains "Low" (logic "0") after all 82 pulses have been generated, the seek error flag (STRB bit 4) is set.

After all 82 pulses have been generated, the head is loaded (HLD becomes a "High"). After the settling time specified in the SUR has expired, the Seek Command End flag is set (ISR bit 1), Busy STRA7 is reset, CTAR and GCR are cleared. The head remains in contact with the disk. A command such as RCR (Read CRC) may be issued following a STZ if the head must be released.

• **Seek (SEK)**

The SEK command is used to position the R/W head over the track on which a Read/Write operation is to be performed. The contents of the GCR are taken as the destination address and the content of the CTAR is the source address; therefore, the number of pulses (N) on the STP output are given by:

$$N = |(CTAR) - (GCR)|$$

HDR is a "High" for (GCR) > (CTAR) otherwise it is a "Low".

When a SEK command is issued, Busy is set, the head is raised from the disk, HDR is set as described above, and N number of pulses appear on the STP output. After the last step pulse is used, the head is placed in contact with the disk. Once the head settling time has expired, the Seek Command End flag (ISR bit 1) is set, Busy is reset, and the contents of the GCR are transferred to the CTAR.

■ **SINGLE SECTOR READ/WRITE COMMANDS**

The single sector Read/Write commands (SSR, RCR, SSW, and SWD) are used to Read/Write data from a single 128 byte sector on the disk. As shown in Figure 19 these types of instructions can be divided into two sections. The first section, which is common to all instructions, is the address search operation, while the second section is unique to the requirements of each instruction.

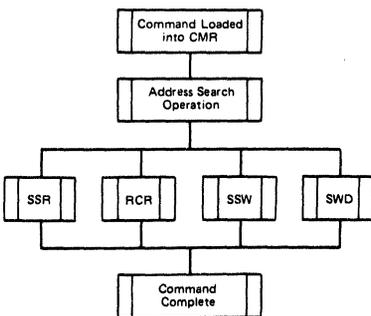


Figure 19 Basic Single Sector Command Flow Chart

• **Address Search Operation**

The flow chart of Figure 20 shows the operation of the address search operation.

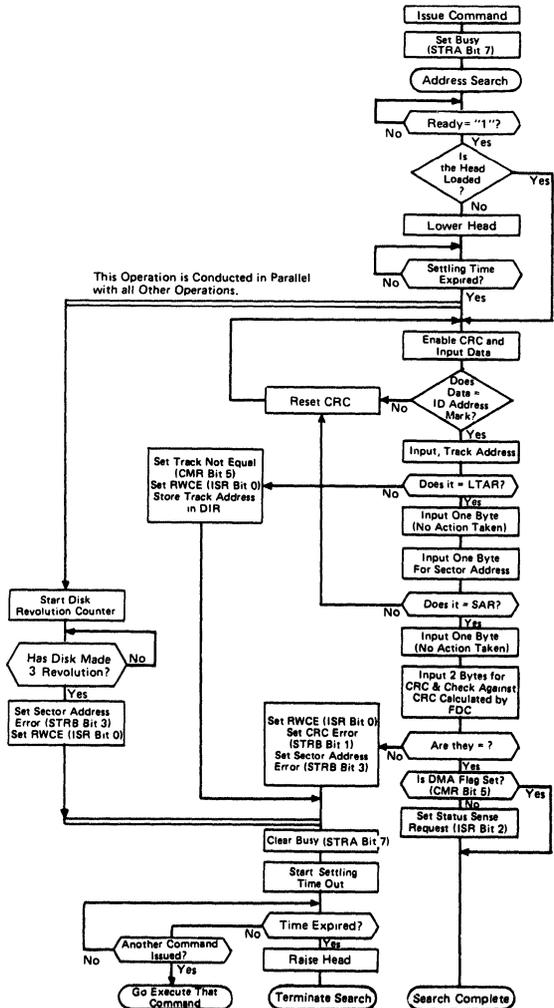


Figure 20 Operational Flow of the Address Search Sequence

• **Single Sector Read (SSR)**

The single sector read command follows the address search procedure as defined in the previous flowchart. If the search is successful, status sense request is set and the operation continues as described by the flowchart of Figure 21.

• **Read CRC (RCR)**

The RCR command is used to verify that correct data was written on a disk. The operation is the same as for the SSR

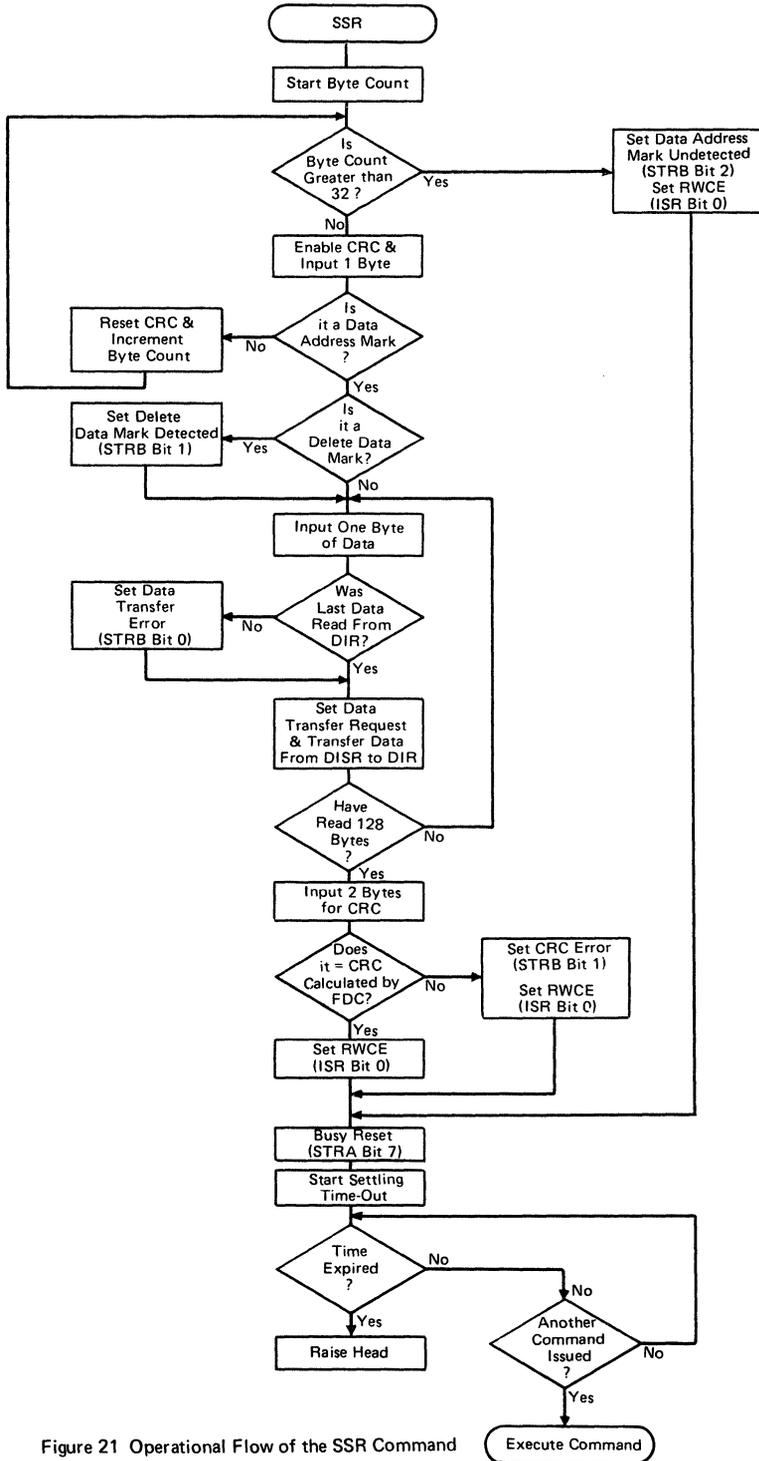


Figure 21 Operational Flow of the SSR Command

command with the exception that the data transfer request (STRA bit 0) is not set. The Status Sense Request interrupt can be disabled by using the DMA flag of CMR.

● **Single Sector Write (SSW)**

Single sector write is used to write 128 bytes of data on the disk. After the command is issued, the address search is performed. The remainder of the instruction's operation is shown in Figure 22.

● **Single Sector Write with Delete Data Mark (SWD)**

The operation flow of SWD is exactly like that of SSW. For SWD, the data pattern of the Data Address Mark becomes F8 instead of FB. The clock pattern remains C7.

● **Multi-Sector Commands (MSR/MSW)**

MSR is used for sequential reading of one or more sectors. If S sectors are to be read, S - 1 must be written into the GCR before the command is issued.

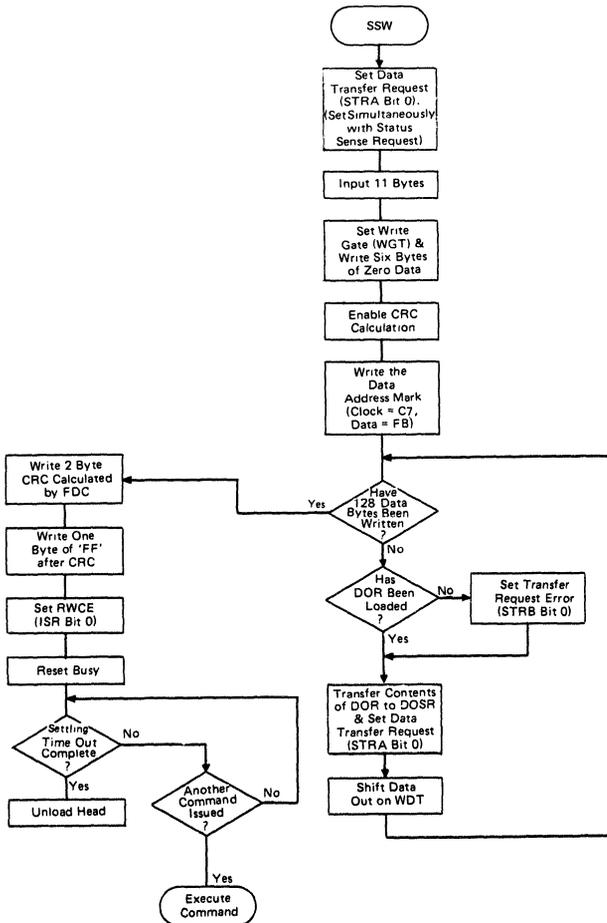


Figure 22 Operational Flow of the SSW Command

The basic operation for the MSR and MSW is the same as that for the SSR and SSW respectively. The basic operation begins with an address search operation, which is followed by a single sector read or write operation. This completes the operation on the first sector. The SAR is incremented, the GCR is decremented, and if no overflow is detected from the GCR (i.e., GCR become negative) the sequence is repeated until S number of sectors are read or written.

The completion of an MSR or MSW is like that of an SSR or SSW command. First RWCE is set and Busy is reset, after the settling time has expired, the head is released.

If a delete data mark is detected during an MSR command, STRA bit 1 (Delete Data Mark Detected) remains set throughout the commands operation.

When a multi-sector instruction is issued, the sum of the SAR and GCR must be less than 27. If SAR + GCR > 26, an address error (STRB bit 3 set) will occur after the contents of SAR becomes greater than 26.

● **Free Format Write (FFW)**

The FFW has two modes of operation which are selected by FWF (Free Format Write Flag) which is data bit 4 of the CMR.

When FWF = "0", the data bits of the DOR are written directly to the disk without first writing the preamble, address mark, etc. The contents of the DOR are FM modulated with a clock pattern of all ones.

If FWF = "1" the odd bits of the DOR are used as clock bits and even bits are used for data bits. In this mode, the DOSR clock is twice a normal write operation and one byte of DOR is one nibble (four bits of data) on the disk.

The two modes of the FFW command allow formatting a disk with either the IBM3470 format or a user defined format.

After the FFW command is loaded into the CMR, WGT becomes a "High" level, the contents of DOR are transferred to the DOSR, data transfer request (STRA bit 0) is set, and the serial bit pattern is shifted out on the WDT line. Therefore, DOR must be loaded before the FFW command is issued. Data from the DOR is continually transferred to the DOSR and shifted out on WDT until the CMR has been written with an all zero pattern. When CMR becomes zero, WGT becomes a "Low" level, but RWCE is not set and the R/W head is left in contact with the disk.

● **Free Format Read (FFR)**

FFR is used to input all data (including Address marks) from a disk. Once the FFR command is set into the CMR, the head is loaded and after the settling time has expired the serial data from the FDC is brought into the DISR. After 8 bits have accumulated, it is transferred to the DIR and Data Transfer Request (STRA bit 0) is set.

This operation continues until a zero pattern is stored in the CMR, terminating the FFR command. As in the case of the FFW command, RWCE is not set and the head remains in contact with the disk.

The first data that enters the DISR is not necessarily the first bit of a data word since the head may be lowered at any place on the disk. To prevent the FDC from remaining unsynchronized to the data, the FFR command will synchronize to an ID address mark (FE) or a Data Address mark (FB or F8) or an Index Address Mark (FC).

■ **REGISTER DEFINITIONS**

● **Data Output Register (DOR); Hex address 0, write only**

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
8 Bits of Data Used for a Disk Write Operation							

When one of the four write macro commands (SSW, SWD, MSW, and FFW) is executed, the information contained in the DOR is loaded into the DOSR, and is shifted out on the WDT line using a double frequency (FM) format.

● **Data Input Register (DIR); Hex address 0, read only**

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
8 Bits of Data Used for a Disk Read Operation							

One of the three read macro commands (SSR, MSR, FFR) executed, will cause the information on the RDT input to be clocked into the DISR. When 8 clock pulses have occurred, the 8 bits of information in the DISR are transferred to the DIR where it can be read by the bus interface.

● **Current Track Address (CTAR); Hex address 1, read/write**

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Track Address of Current Head position							

The address of the track over which the R/W head is currently positioned is contained in the CTAR. At the end of a SEK command, the contents of the GCR are transferred to the CTAR. CTAR is cleared at the completion of a STZ command. CTAR is a read/write register so that the head position can be updated when several drives are connected to one FDC. Bit 7 is read as a "0".

● **Command Register (CMR); Hex address 2, write only**

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3*	Bit 2*	Bit 1*	Bit 0*
Function Interrupt Mask	ISR3 Interrupt Mask	DMA Flag	FWF	Macro Command			

*Bit 0 ~ 3 are cleared by RES.

The commands that control the FDC are loaded into the lower four bits of the CMR. Information that controls the data transfer mode and interrupt conditions are loaded into bits four through seven.

Bit 0~Bit 3: Macro Command

The Macro Command to be executed by the FDC is written to bits 0~3.

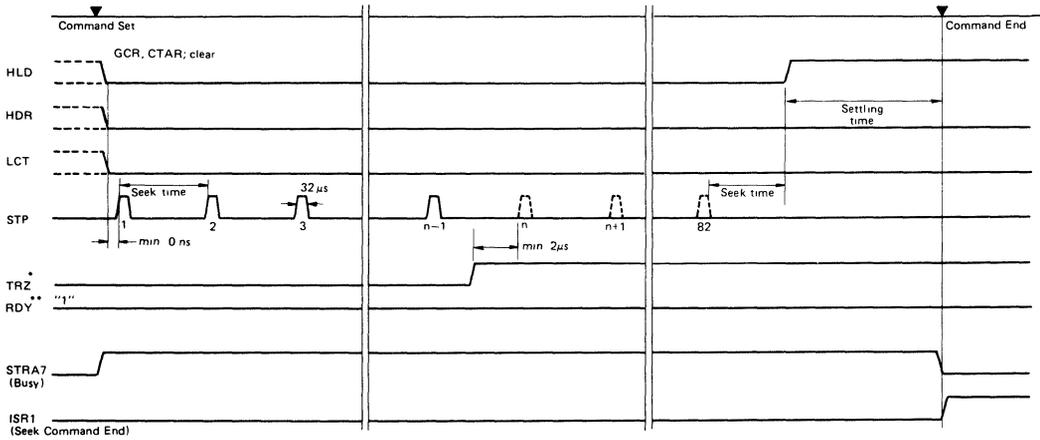
Bit 4: Free Format Write Flag (FWF)

If a Free Format Write command is issued, the state of bit 4 of the CMR determines what clock source will be used. The FWF is defined in the FFW (Free Format Write) command explanation.

Bit 5: DMA Flag

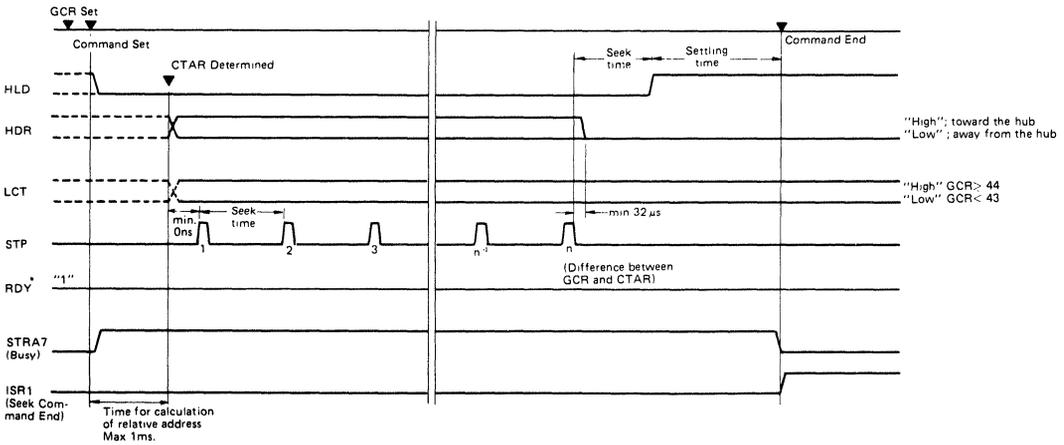
If bit 5 is a "1" the FDC is in the DMA mode. Bit 5 being a "1" inhibits setting of Status Sense Request (ISR bit 2) thereby preventing its associated interrupt. A logic "1" DMA flag also enables the TxRQ output allowing it to request DMA transfers when the Data Transfer Request flag (STRA bit 0) is set.

A logic "0" DMA flag indicates the program controlled I/O (PC I/O) mode.



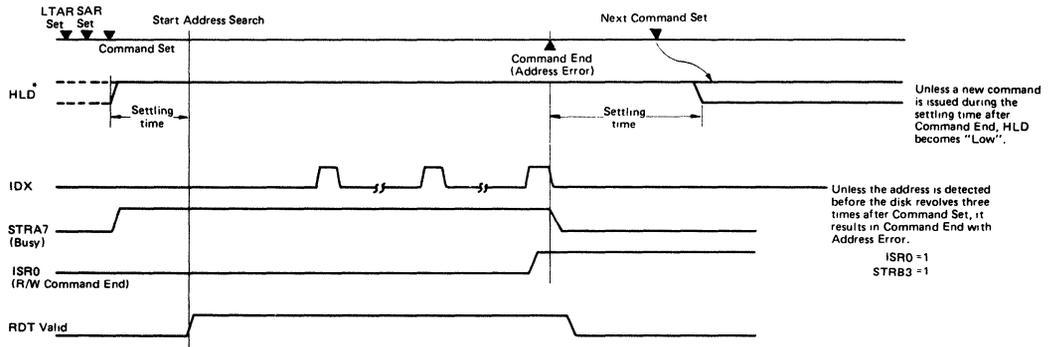
- * STP output is masked when TRZ becomes "High". But if TRZ falls to "Low" again before 82 pulse outputs are all provided STP output become available again from that time point.
- ** When RDY is "Low" with Command Set, the execution is postponed until RDY becomes "High".

Figure 23 Timing Sequence of STZ Command



- * When RDY is "Low" with Command Set, the execution is postponed until RDY becomes "High".

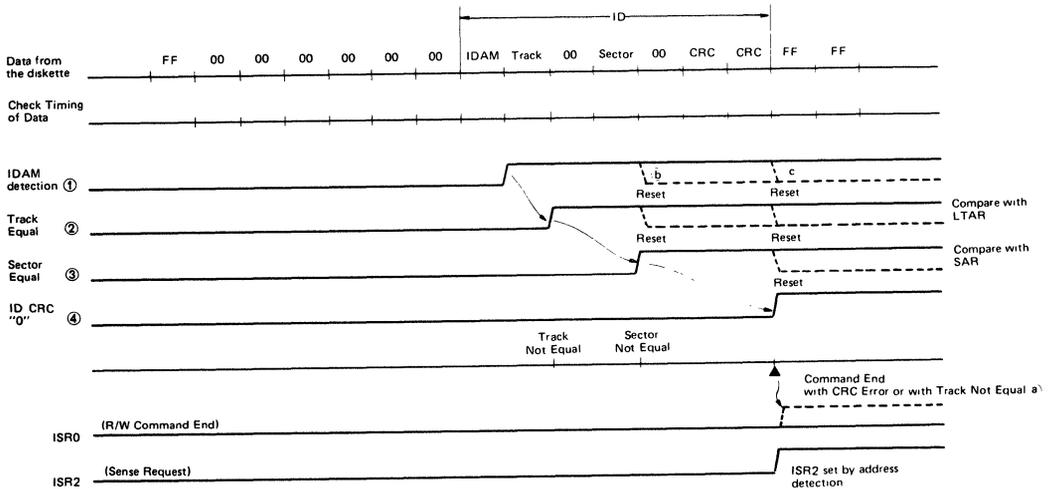
Figure 24 Timing Sequence of SEK Command



* If HLD has already been "High" when the command is set, the FDC starts the address search immediately.

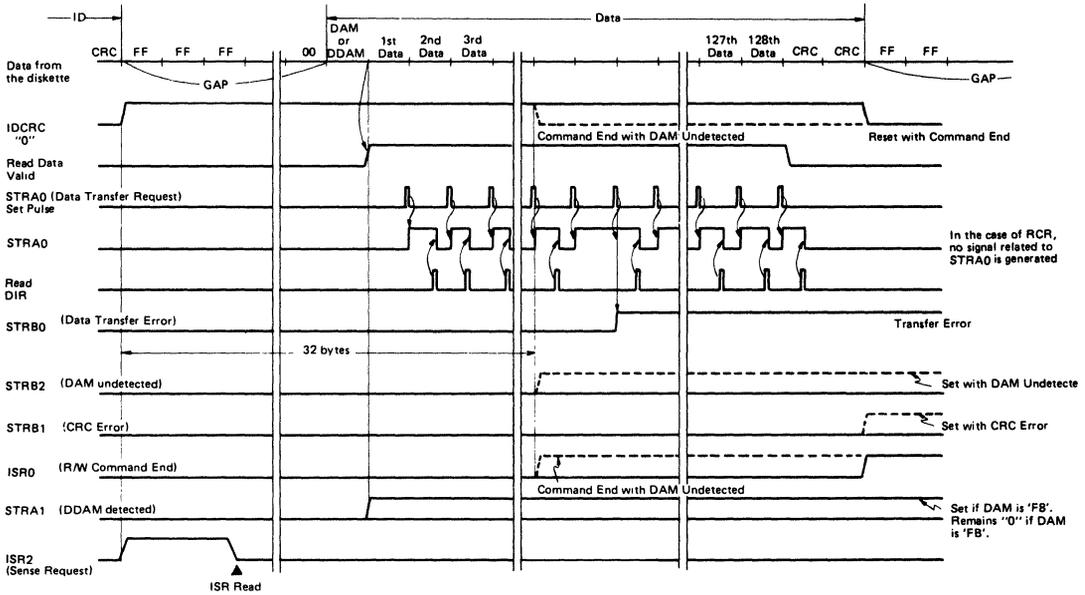
When RDY is "Low" with Command Set, the FDC waits for the execution until RDY becomes "High".

Figure 25 Timing Sequence of SSR, SSW, RCR, SWD, MSR, MSW Command (Relation with HLD and IDX)



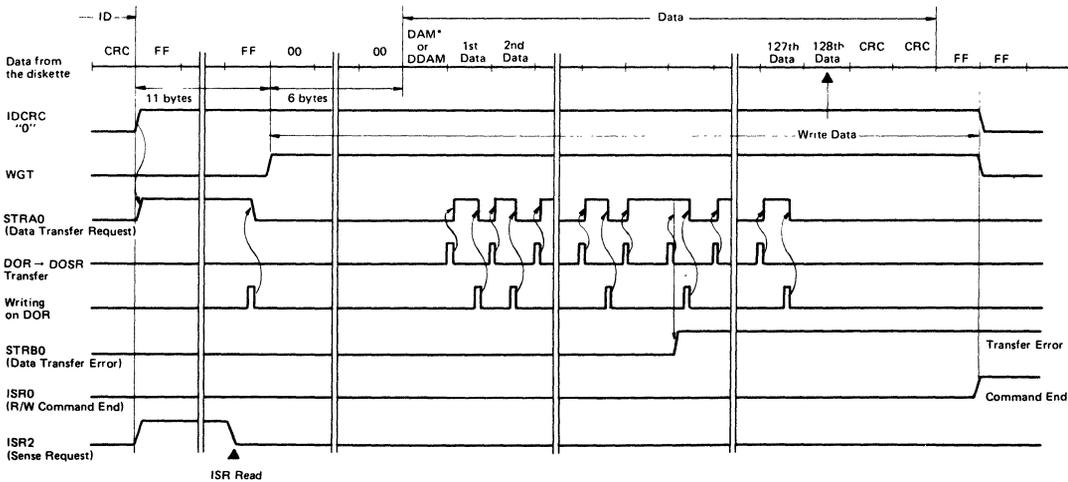
- Ⓐ ; In the case of Track Not Equal, ② is not set and if CRC equals to the one calculated by FDC, STRA5 is set.
 - Ⓑ ; In the case of Sector Not Equal, ③ is not set and ① & ② are reset to search the next IDAM.
 - Ⓒ ; In the case of CRC Error, ④ is not set and ①, ② & ③ are reset. (ISR0: Set, STRB1: Set, STRB3: Set)
- When ①, ②, ③, & ④ are all set, ISR2 is Set. These four signals are reset with Command End. When ④ is "1", go to the data transfer routine.

Figure 26 Internal Timing Sequence of Address Search Routine



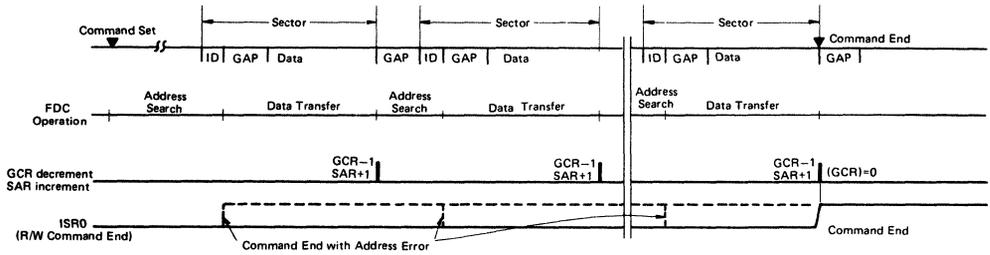
Unless DAM(FB) or DDAM(F8) is detected within 32 bytes after ID field has been detected, STRB2 is set to end the command.

Figure 27 Data Transfer Timing of SSR, RCR Command



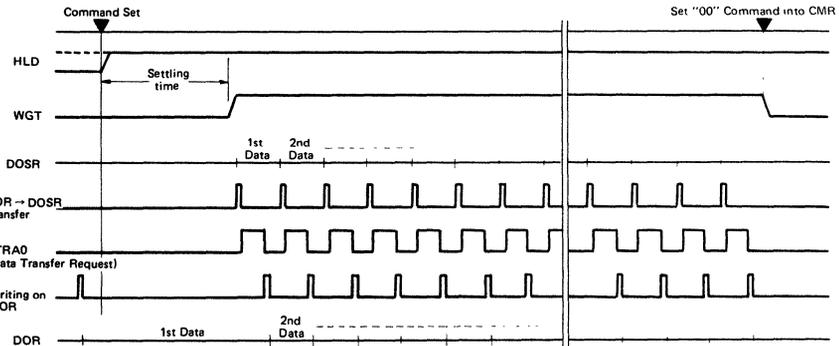
* As Data Address Mark, SSW command writes 'FB' and SWD command writes 'F8'.

Figure 28 Data Transfer Timing of SSW, SWD Command



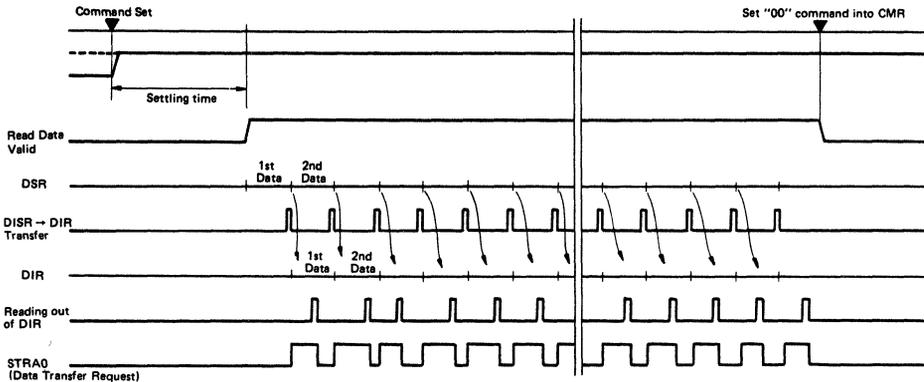
Address Search and Data Transfer in each sector is the same as those of SSR or SSW command. When Address Error occurs, it results in Command End. If an error relating to Data Transfer occurs, Error flag is set. But the command continues to be executed to shift into the next sector.

Figure 29 Timing Sequence of MSR, MSW Command



- The first one-byte data must be set into DOR before Command Set.
- If HLD has already been "High" when the command is set, WGT becomes "High" immediately.
- When "00" command is set into CMR, an interrupt of Command End is not generated.

Figure 30 Timing Sequence of FFW Command



If HLD has already been "High" when the command is set, Read operation starts immediately without waiting for the settling time. When "00" command is set into CMR, an interrupt of Command End is not generated.

Figure 31 Timing Sequence of FFR Command

Bit 6: ISR3 Interrupt Mask

CMR bit 6 (ISR3 Mask) is used to control the operation of ISR bit 3. A logic "1" in CMR bit 6 inhibits output of STRB-OR-Interrupt signal to \overline{IRQ} . If CMR bit 6 (ISR3 Mask) and CMR bit 7 are "0" STRB-OR-Interrupt signal will be output to \overline{IRQ} .

Bit 7: Function Interrupt Mask

When CMR bit 7 is a logic "1" all interrupts are inhibited.

Table 5

Causes of Interrupt	Command Register Masks That Affect Interrupts		
	CMR7 (Function Interrupt Mask)	CMR6 (ISR3 Mask)	CMR5 (DMA Flag)
ISR0 (Read write Command End)	M	x	x
ISR1 (Seek Command End)	M	x	x
ISR2 (Status Sense Request)	M	x	M
ISR3 (STRB-OR-Interrupt)	M	M	x

x = No effect
M = Bits that are used as masks

Interrupt Status Register (ISR); Hex address 2, read only

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2*	Bit 1*	Bit 0*
Not Used (Read as "0")				STRB-OR	Status Sense Request	Seek Command End	Read Write Command End

* Cleared by \overline{RES}

Bit 0: Read Write Command End (RWCE)

When an SSR, RCR, SSW, SWD, MSR or MSW Macro Command has completed execution, bit 0 becomes set (logic "1"). If the function interrupts are enabled (bit 7 of CMR is a logic "0"), the conclusion of a Macro Command's execution will cause an interrupt.

Bit 1: Seek Command End (SCE)

Seek Command End is set on SEK and STZ commands to indicate the head has been loaded and the settling time specified in SUR has expired. Since RWCE is not set for the SEK or STZ command, SCE can be used as an interrupt to signify the SEK or STZ command has finished. SCE is not set for any of the R/W commands.

Bit 2: Status Sense Request

For an SSR, SSW, SWD, MSR, or MSW Command, Status Sense Request indicates that the specified address ID field has been detected and verified by a CRC check. This is used as an early indication that data transfers will occur after 18 more byte

times. For MSR and MSW commands, it is set for each sector.

In the PC I/O mode, an interrupt occurs when Status Sense Request becomes a logic "1". In the DMA mode, (DMA flag of CMR is set) Status Sense Request is unchanged and does not generate an interrupt when the address ID field has been verified.

Bit 3: STRB-OR

STRB-OR is an "OR" of all of the bits of Status Register B.

$$\text{STRB-OR} = \text{STRB0} + \text{STRB1} + \text{STRB2} + \text{STRB3} + \text{STRB4} + \text{STRB5} + \text{STRB6} + \text{STRB7}$$

$$\text{STRB-OR-Interrupt} = \text{STRB1} + \text{STRB2} + \text{STRB3} + \text{STRB4} + \text{STRB5} + \text{STRB6} + \text{STRB7}$$

STRB-OR-Interrupt signal causes \overline{IRQ} . STRB-OR is read by Read ISR. STRB0 (Data Transfer Error) sets ISR Bit 3 but does not cause Interrupt.

ISR0, ISR1, and ISR2 are cleared when the Interrupt Status Register is read, but ISR3 is cleared only after Status Register B has been read except when FI input is "High".

Set-Up Register (SUR); Hex address 3, write only

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Track to Track Seek Time				Head Settling Time			

The SUR is not affected by a reset operation; therefore, once it is initialized, the information remains until power is removed from the FDC.

Bit 0 ~ Bit 3: Head Settling Time

The head settling time is used to generate a delay after the head is placed in contact with the disk. This allows the head to stop bouncing before any operations are performed. The delay is programmed by bits 0~3 and is specified by the equation:

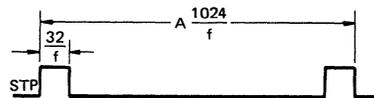
$$\text{Delay} = \frac{4096}{f} \cdot B$$

B = Number contained in bits 0~3 of SUR
f = Frequency of CLK input

For IBM3740 compatibility f = 1 MHz and the timing range is 4.096 ms for a "0001" to 61.44 ms for a "1111". A "0000" code prevents Settling Time complete from being set and the FDC must be Reset.

Bit 4 ~ Bit 7: Track to Track Seek Time

The frequency of STP is determined by bit 4~7 of SUR as shown below.



A = Number specified in bits 4~7 of SUR.
f = Frequency of CLK input.

For IBM compatible operation, f is 1 MHz. This results in an STP pulse width of 32 μs and an STP interval of 1.024 ms for a "0001" to 15.36 ms for a "1111".

● **Status Register A (STRA); Hex address 3, read only**

Bit 7*	Bit 6	Bit 5*	Bit 4	Bit 3	Bit 2	Bit 1*	Bit 0*
Busy	Index	Track Not Equal	Write Protect	Track Zero	Drive Ready	Delete Data Mark Detected	Data Transfer Request

* Cleared by \overline{RES}

Bit 0: Data Transfer Request

For a write operation (SSW, SWD, MSW, FFW) the transfer request bit indicates that the DOR is ready to accept the next data word to be written on the disk. If data is not written into the DOR before the last data bit in the DOSR is shifted out to the WDT line; the data transfer error bit (bit 0 of STRB) will be set. After a write command has been issued, the first transfer request occurs simultaneously with the Status Sense Request. For a write operation, transfer request is reset after the DOR has been written from the data bus.

During a read operation (SSR, MSR, FFR) the transfer request bit signifies data from the DISR has been transferred to the DIR. The DIR must be read before the DISR is full again or the data transfer error bit (bit 0 of STRB) will be set. For read operations, transfer request is reset by a read of the DIR.

Bit 1: Delete Data Mark Detected

A Single Sector Read operation that detects a delete data code (F8) instead of a general data code (FB) as a Data Address Mark will set the Delete Data Mark Detected bit. For the MSR command, bit 1 is set the first time an "F8" code is found and remains set throughout the execution of the command. Bit 1 is reset whenever an SSR, SSW, SWD, MSR, MSW, or RCR command is issued.

Bit 2: Drive Ready

The Drive Ready bit indicates the state of the Ready input from the floppy disk drive. If a command is issued with Ready at logic "0", its execution will be inhibited until Ready becomes a logic "1". If ready becomes a "0" during the execution of a command the Hard Error Flag (STRB bit 7) is set.

Bit 3: Track Zero

The state of the Track Zero input from the floppy disk drive is reflected in this bit of STRA. A logic "1" on the Track Zero input inhibits step pulses during an STZ command.

Bit 4: Write Protect

The Write Protect input from the floppy disk drive is reflected by bit 4 of STRA. A "High" level (logic "1") on the WPT input during the execution of any write command results in a write error (bit 6 of STRB set).

Bit 5: Track Not Equal

If the track address read from the address ID field does not coincide with the address in the LTAR in spite of CRC matching the one calculated by FDC, the Track Not Equal bit is set. Track Not Equal applies to all non-free format read/write commands, and is reset after a non-free format read/write command is issued.

Bit 6: Index

The state of the index input appears in bit 6 of STRA. The index input is used to count the number of disk revolutions while the FDC is looking for the address ID field (see operation

of STRB bit 3) during the address search phase of a non-free format read/write command.

Bit 7: Busy

When Busy is a logic "1", the FDC is executing a command and no new commands can be issued. Busy should be confirmed to be "0" before reading ISR or STRB as well as issuing a command.

● **Sector Address Register (SAR); Hex address 4, write only**

Bit 7	Bit 6	Bit 5	Bit 4*	Bit 3*	Bit 2*	Bit 1*	Bit 0*
Not Used				5 Bit Sector Address			

* Cleared by \overline{RES}

Before a data transfer macro command (SSW, SWD, SSR, RCR, MSW, MSR) is issued, the address of the sector on which the operation is to be performed must be written into the SAR. The address in the sector address byte of an Address ID field of the disk is compared with the contents of the SAR. During an MSW or MSR command, the SAR is incremented after each sector is read or written. When execution is complete, the SAR contains the address of the last sector on which an operation was performed plus one.

● **Status Register B(STRB); Hex address 4, read only**

Bit 7*	Bit 6*	Bit 5	Bit 4*	Bit 3*	Bit 2*	Bit 1*	Bit 0*
Hard Error	Write Error	File Inoperable	Seek Error	Sector Address Undetected	Data Mark Undetected	CRC Error	Data Transfer Error

* Cleared by \overline{RES}

The bits of the STRB represent possible error conditions that may occur during execution of macro commands. Whenever STRB is reset, ISR bit 3 is also reset.

Bit 0: Data Transfer Error

Data Transfer Error indicates an underflow or overflow of data. If a Write operation is being performed, it signifies that data was not presented to the DOR before the DOSR became empty. In this case, the current contents of the DOR are transferred to the DOSR and the write operation continues. The data transfer error remains set until STRB is read, and the data transfer request remains set until data is written into the DOR. The operation of the CRC is unchanged.

For read commands, a data transfer error indicates that data in the DIR was not read before the next data word from the disk was transferred to the DIR. The read operation continues until sufficient data has been read from the disk to satisfy the requirements of the command (128 bytes for SSR). The error indication remains set until STRB is read, and the transfer request remains set until data is read from the DIR.

Bit 1: CRC Error

A CRC error occurs when the CRC read from the disk does not match that calculated by the FDC on the data it reads from the disk. A CRC error can occur in two different situations; checking the address ID field, checking the data field.

If the CRC error occurs during the check of an address ID field, Sector Address Undetected (STRB bit 3) will also be indicated (see Table 6). A CRC error of a data field is indicated by a CRC Error and no Sector Address Undetected.

Bit 2: Data Mark Undetected

If a valid data mark is not detected in the data block of a sector, it is indicated by a Data Mark Undetected error.

Bit 3: Sector Address Undetected

The Sector Address Undetected bit can be set on two conditions; not finding the sector address and a CRC error on an address ID field.

If the disk makes three revolutions during an address search operation and the sector address specified in the sector address register is not found in any of the address ID fields, a Sector Address Undetected condition is indicated.

A CRC error that occurs on an address ID field will set bit 3 also. Table 6 shows how bits 1 and 3 are related.

Table 6 Relationship of CRC Error and Sector Address Undetected

CRC Error (STRB1)	Sector Address Undetected (STRB3)	Condition
0	0	No Error
0	1	Sector Address not Detected
1	0	CRC Error on a Data Field
1	1	CRC Error on Address ID Field

Bit 4: Seek Error

An STZ (Seek Track Zero) command that never receives a track zero indication on the track zero input will result in a Seek Error (see description of STZ command).

Bit 5: File Inoperable

The state of the File Inoperable input appears in bit 5. If the File Inoperable input is a "High" level, a pulse of width equals to Enable pulse width PW_{EL} is issued on the FIR output when STRB is read. FI is not latched but the input is gated to the bus when STRB is read.

Bit 6: Write Error

If the WPT input becomes a "High" level (logic "1") during the execution of a write command the Write Error bit is set.

Bit 7: Hard Error

If the Ready input becomes a "Low" level during the operation of a command (Busy is set), a Hard Error indication will result.

• **General Count Register (GCR); Hex address 5, write only**

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Not Used	7 Bit Count for Track Number on SEK Command and Sector Count for MSR or MSW Command						

The GCR contains the destination track address for the R/W head on an SEK Macro Command. The contents of the GCR are transferred to the CTAR at the end of the SEK Command. For multi-sector read or write operations (MSR, MSW), the GCR contains the number of sectors to be read minus one. During the MSR or MSW execution the GCR is decremented after each sector is read or written.

• **CRC Control Register (CCR) ; Hex address 6, write only**

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Not Used						Shift CRC	CRC Enable

The CCR information is used only in the free format commands; for all other commands this register is masked and has no function.

Bit 0: CRC Enable

During an FFW command, CRC Enable is set by software and CRC generation takes effect on the next transfer of data from DOR to DOSR (see figure 32). The CRC generation continues until Shift CRC (CCR bit 1) is set.

For an FFR command, CRC Enable is set by software and CRC generation takes effect on the next data read from DIR. The calculation continues for all data bytes read from DIR until CRC Enable is reset. The bytes read previous to resetting CRC Enable are considered the CRC information bytes and the CRC check is made against them.

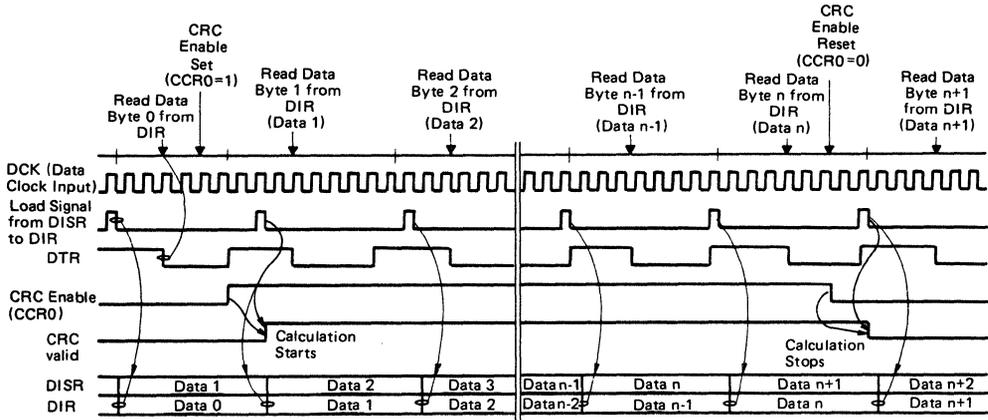
Bit 1: Shift CRC

Bit 1 is valid only for the FFW command. After setting, it takes effect on the next transfer of data from DOR to DOSR (see Figure 33). Setting Shift CRC terminates the CRC calculation and causes the CRC calculated on all the data written into DOR up to the setting of bit 1, to be shifted out the WDT output. The CRC calculation will not include any data written to DOR after Shift CRC is set.

• **LTAR (Logical Track Address); Hex address 7, write only**

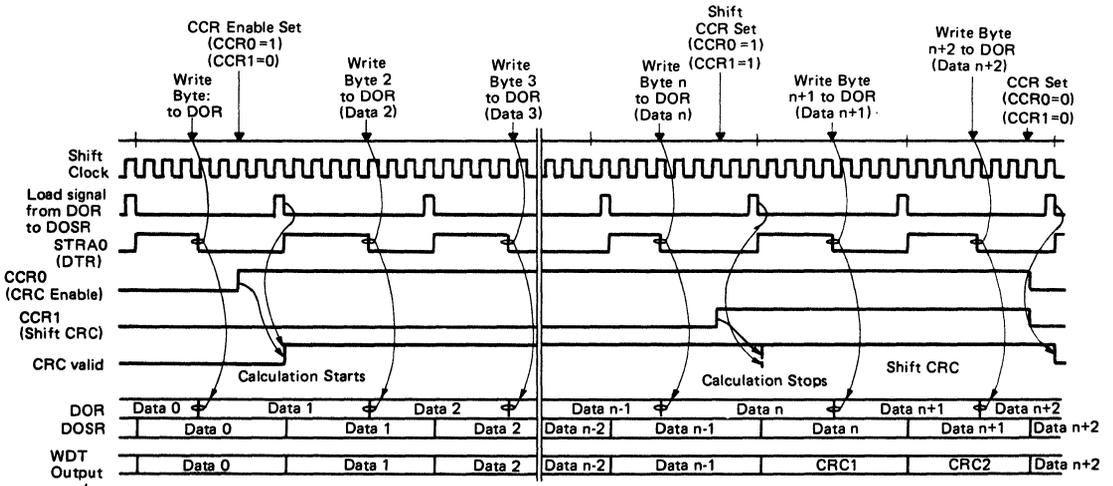
Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Not Used	7 Bit Logical Track Address						

When a read or write macro command (SSW, SWD, SSR, RCR, MSW, MSR) is issued, the address of the track on which the operation is to be performed must be written into the LTAR. The address in the track address byte of an Address ID field of the disk is compared with the contents of the LTAR. The contents of LTAR are not affected by the execution of any of the commands.



CRC Calculation includes Data Byte 1 through Data Byte n.

Figure 32 CCR Control Register Timing for an FFR Command (READ)



The CRC Calculation includes Data Byte 1 through Data Byte n-1.

Figure 33 CCR Control Register Timing for an FFW Command (WRITE)

Table 7 Programming Reference Data

Table 7 is a summary of the information in the data sheet and can be used as a reference when programming the HD6843.

Registers	Hex Address	R/W Mode	Data Bits							
DOR	0	WO	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
			8 Bits of Data Used for a Disk Write Operation							
DIR	0	RO	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
			8 Bits of Data Used for a Disk Read Operation							
CTAR	1	R/W	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
			Track Address of Current Head Position							
CMR	2	WO	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3 *	Bit 2 *	Bit 1 *	Bit 0 *
			Function Interrupt Mask	ISR3 Interrupt Mask	DMA Flag	FWF	Macro Command			
ISR	2	RO	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2 *	Bit 1 *	Bit 0 *
			Not Used				STRB -OR	Status Sense Request	Seek Command End	Read Write Command End
SUR	3	WO	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
			Track to Track Seek Time				Head Settling Time			
STRA	3	RO	Bit 7 *	Bit 6	Bit 5 *	Bit 4	Bit 3	Bit 2	Bit 1 *	Bit 0 *
			Busy	Index	Track Not Equal	Write Protect	Track Zero	Drive Ready	Delete Data Mark Detected	Data Transfer Request
SAR	4	WO	Bit 7	Bit 6	Bit 5	Bit 4 *	Bit 3 *	Bit 2 *	Bit 1 *	Bit 0 *
			Not Used				5 Bit Sector Address			
STRB	4	RO	Bit 7 *	Bit 6 *	Bit 5	Bit 4 *	Bit 3 *	Bit 2 *	Bit 1 *	Bit 0 *
			Hard Error	Write Error	File Inoperable	Seek Error	Sector Address Undetected	Data Mark Undetected	CRC Error	Data Transfer Error
GCR	5	WO	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
			Not Used	7 Bit Count for Track Number on SEK or Sector Count for MSR or MSW.						
CCR	6	WO	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
			Not Used							Shift CRC
LTAR	7	WO	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
			Not Used	7 Bit Logical Track Address						

RO – Read Only
 WO – Write Only
 R/W – Read/Write

* Cleared by \overline{RES}

MACRO COMMANDS

Hex Code	Instruction	Hex Code	Instruction
2	STZ	A	FFR
3	SEK	B	FFW
4	SSR	C	MSR
5	SSW	D	MSW
6	RCR		
7	SWD		

Table 8 Error Condition, Command Execution, Interrupt, and Head Control

Error	Flag	Set Condition	Reset Condition	Command	Command Execution	Interrupt	Head Control
Track Not Equal	STRA5	Track information of ID field is not equal to the content of LTAR.	Issuing of SSR, RCR, MSR, SSW, SWD or MSW Command	SSR, RCR, MSR SSW, SWD, MSW	The execution of a command is interrupted and R/W Command End (ISR0) is set.	Request (ISR0)	Unchanged**
Data Transfer Error	STRB0	Overflow or underflow during the data transfer	Reading of STRB	SSR, MSR, SSW, SWD, MSW, FFR FFW	Read/Write command continues to be executed.	No interrupt	Unchanged**
CRC Error	STRB1	CRC Error on ID field or Date field	Reading of STRB	SSR, RCR, MSR, SSW, SWD, MSW (FFR)	The execution of a command is interrupted and R/W Command End (ISR0) is set.	Request (ISR0, ISR3)	Unchanged**
Data Mark Undetected	STRB2	DAM or DDAM is undetected within 32 bytes after ID field has been detected.	Reading of STRB	SSR, RCR, MSR	The execution of a command is interrupted and R/W Command End (ISR0) is set.	Request (ISR0, ISR3)	Unchanged**
Sector Address Undetected	STRB3	(1) Sector Address of ID field is not equal to the content of SAR. (2) CRC Error on ID field	Reading of STRB after Busy (STRA7) is reset.	SSR, RCR, MSR SSW, SWD, MSW	The execution of a command is interrupted and R/W Command End (ISR0) is set.	Request (ISR0, ISR3)	Unchanged (Head remains loaded after settling time has expired.)
Seek Error	STRB4	TRZ signal remains "Low" level though eighty-two STP pulse outputs are provided in STZ command.	Reading of STRB	STZ	The execution of a command is interrupted and Seek Command End (ISR1) is set.	Request (ISR1, ISR3)	Unchanged
File Inoperable	STRB5	A "High" level input of FI terminal is reflected.	FI signal of the FDD is reset when "High" pulse output is provided by reading of STRB at FI="1".	All commands	The execution of a command is interrupted. If it is a Read/Write command, ISR0 is set. If it is a seek command, ISR1 is set.	Request (ISR0 or ISR1, ISR3)	Unload the head immediately (HLD="Low") Set WGT to "Low"
Write Error	STRB6	Write operation (WGT="High") is performed when the input of WPT terminal is "High" level.	Reading of STRB	SSW, SWD, MSW FFW	The execution of a command is interrupted and R/W Command End (ISR0) is set.	Request (ISR0, ISR3)	Unload the head immediately (HLD="Low") Set WGT to "Low"
Hard Error	STRB7	RDY input signal becomes "Low" level during the execution of a command (Busy="1").	Reading of STRB	All commands	The execution of a command is interrupted. If it is a Read/Write command, ISR0 is set. If it is a seek command, ISR1 is set.	Request (ISR0 or ISR1, ISR3)	Unload the head immediately (HLD="Low") Set WGT to "Low"
Not Ready during the idling	STRA2	-	-	-	-	No interrupt	Unload the head immediately (HLD="Low")

* These errors except STRB5 and STRA2 are reset by RES inputs.

** Head is unloaded if the new command is not issued during the settling time after Read/Write command ends.

HD6844, HD68A44, HD68B44 DMAC (Direct Memory Access Controller)

The HD6844 Direct Memory Access Controller (DMAC) performs the function of transferring data directly between memory and peripheral device controllers. It controls the address and data buses in place of the MPU in bus organized systems such as the HMCS6800 Microprocessor System.

The bus interface of the HD6844 includes select, read/write, interrupt, transfer request/grant, and bus interface logic to allow the data transfer over an 8-bit bidirectional data bus. The functional configuration of the DMAC is programmed via the data bus. The internal structure provides for control and handling of four individual channels, each of which is separately configured. Programmable control registers provide control for the transfer location and length, individual channel control and transfer mode configuration, priority of servicing, data chaining, and interrupt control. Status and control lines provide control to the peripheral controllers.

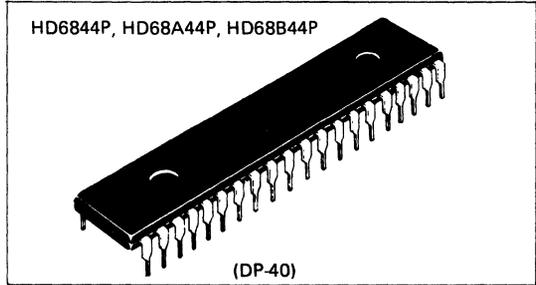
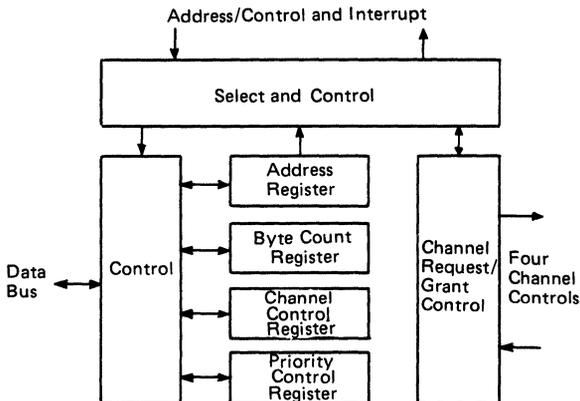
The mode of transfer for each channel can be programmed as cycle-stealing or a burst transfer mode.

Typical applications would be with the Floppy Disk Controller (FDC), etc..

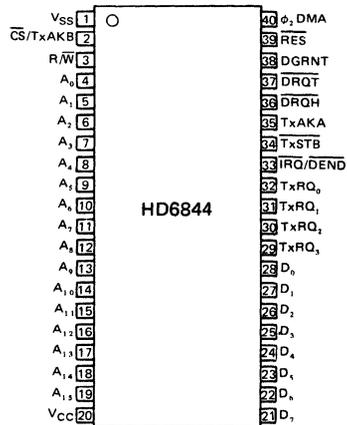
■ FEATURES

- Four DMA Channels, Each Having a 16-Bit Address Register and a 16-Bit Byte Count Register
- 1 M Byte/Sec (HD6844), 1.5 M Byte/Sec (HD68A44), 2.0 M Byte/Sec (HD68B44)
Maximum Data Transfer Rate
- Selection of Fixed or Rotating Priority Service Control
- Separate Control Bits for Each Channel
- Data Chain Function
- Address Increment or Decrement Update
- Programmable Interrupts and DMA End to Peripheral Controllers
- Compatible with MC6844, MC68A44, MC68B44

■ BLOCK DIAGRAM



■ PIN ARRANGEMENT



(Top View)

■ ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Value	Unit
Supply Voltage	V_{CC}^*	-0.3 ~ +7.0	V
Input Voltage	V_{in}^*	-0.3 ~ +7.0	V
Operating Temperature	T_{opr}	-20 ~ +75	°C
Storage Temperature	T_{stg}	-55 ~ +150	°C

* With respect to V_{SS} (SYSTEM GND)

(NOTE) Permanent LSI damage may occur if maximum ratings are exceeded. Normal operation should be under recommended operating conditions. If these conditions are exceeded, it could affect reliability of LSI.

■ RECOMMENDED OPERATING CONDITIONS

Item	Symbol	min	typ	max	Unit
Power Supply Voltage	V_{CC}^*	4.75	5.0	5.25	V
Input Voltage	V_{IL}^*	-0.3	-	0.8	V
	V_{IH}^*	2.0	-	V_{CC}	V
Operating Temperature	T_{opr}	-20	25	75	°C

* With respect to V_{SS} (SYSTEM GND)

■ ELECTRICAL CHARACTERISTICS ($V_{CC}=5V\pm 5\%$, $V_{SS}=0V$, $T_a=-20\sim+75^\circ C$, unless otherwise noted.)

● DC CHARACTERISTICS

Item	Symbol	Test Condition	min	typ*	max	Unit	
Input "High" Voltage	V_{IH}		2.0	-	V_{CC}	V	
Input "Low" Voltage	V_{IL}		-0.3	-	0.8	V	
Input Leakage Current	I_{in}	$T_xRQ_0\sim_3, \phi_2 DMA, \overline{RES}, DGRNT$ $V_{in}=0\sim 5.25V$	-2.5	-	2.5	μA	
Three-State (off state) Leakage Current	I_{TSI}	$A_0\sim A_{15}, D_0\sim D_7, R/\overline{W}$	-10	-	10	μA	
		$D_0\sim D_7$					
Output "High" Voltage	V_{OH}	$I_{OH}=-205\mu A$	2.4	-	-	V	
		$I_{OH}=-145\mu A$	2.4	-	-		
		$I_{OH}=-100\mu A$	2.4	-	-		
Output "Low" Voltage	V_{OL}	$I_{OL}=1.6mA$	-	-	0.4	V	
Source Current	I_{CSS}	\overline{CS}/T_xAKB $V_{in}=0V, Fig. 10$	-	10	16	mA	
Power Dissipation	P_D		-	500	1000	mW	
Input Capacitance	C_{in}	$\phi_2 DMA$	$V_{in}=0V, T_a=25^\circ C$ $f=1.0MHz$	-	-	20	pF
		$D_0\sim D_7, \overline{CS}, A_0\sim A_4, R/\overline{W}$		-	-	12.5	
		$T_xRQ_0\sim_3, \overline{RES}, DGRNT$		-	-	10	
Output Capacitance	C_{out}	$V_{in}=0V, T_a=25^\circ C, f=1MHz$	-	-	12	pF	

* $V_{CC}=5.0V, T_a=25^\circ C$

● AC CHARACTERISTICS (Load Condition Fig. 9)

1. CLOCK TIMING

Item	Symbol	Test Condition	HD6844			HD68A44			HD68B44			Unit
			min	typ	max	min	typ	max	min	typ	max	
ϕ_2 DMA Cycle Time	$t_{cyc\phi}$	Fig. 2	1000	—	—	666	—	—	500	—	—	ns
ϕ_2 DMA Pulse Width	"High" Level $PW_{\phi H}$	Fig. 2	450	—	—	280	—	—	235	—	—	ns
	"Low" Level $PW_{\phi L}$	Fig. 2	400	—	—	230	—	—	210	—	—	ns
ϕ_2 DMA Rise and Fall Time	$t_{\phi r}, t_{\phi f}$	Fig. 2	—	—	25	—	—	25	—	—	25	ns

2. DMA TIMING (Load Condition Fig. 9)

Item	Symbol	Test Condition	HD6844			HD68A44			HD68B44			Unit
			min	typ	max	min	typ	max	min	typ	max	
TxRQ Setup Time	ϕ_2 DMA Rising Edge t_{TQS1}	Fig. 3	120	—	—	120	—	—	120	—	—	ns
	ϕ_2 DMA Falling Edge t_{TQS2}		210	—	—	210	—	—	155	—	—	
TxRQ Hold Time	ϕ_2 DMA Rising Edge t_{TQH1}	Fig. 3	20	—	—	10	—	—	10	—	—	ns
	ϕ_2 DMA Falling Edge t_{TQH2}		20	—	—	10	—	—	10	—	—	
DGRNT Setup Time	DGRNT t_{DGS}	Fig. 4	155	—	—	125	—	—	115	—	—	ns
DGRNT Hold Time	DGRNT t_{DGH}		10	—	—	10	—	—	10	—	—	
Address Output Delay Time	$A_0 \sim A_{15}, R/\bar{W}, \overline{TxSTB}$ t_{AD}	Fig. 6	—	—	270	—	—	180	—	—	160	ns
Address Output Hold Time	$A_0 \sim A_{15}, R/\bar{W}$ t_{AHO}	Fig. 6	30	—	—	20	—	—	20	—	—	ns
	\overline{TxSTB}	Fig. 7	35	—	—	35	—	—	35	—	—	
Address Three-State Delay Time	$A_0 \sim A_{15}, R/\bar{W}$ t_{ATSD}	Fig. 7	—	—	270	—	—	270	—	—	270	ns
Address Three-State Recovery Time	$A_0 \sim A_{15}, R/\bar{W}$ t_{ATSR}	Fig. 7	—	—	270	—	—	270	—	—	270	ns
Delay Time	$\overline{DRQH}, \overline{DRQT}$ t_{DQD}	Fig. 5	—	—	375	—	—	250	—	—	210	ns
TxAK Delay Time	ϕ_2 DMA Rising Edge t_{TKD1}	Fig. 5	—	—	400	—	—	310	—	—	250	ns
	DGRNT Rising Edge t_{TKD2}	Fig. 8	—	—	190	—	—	160	—	—	150	
$\overline{TRQ}/\overline{DEND}$ Delay Time	ϕ_2 DMA Falling Edge t_{DED1}	Fig. 6	—	—	300	—	—	250	—	—	210	ns
	DGRNT Rising Edge t_{DED2}	Fig. 8	—	—	190	—	—	160	—	—	125	

3. BUS TIMING

1) READ TIMING

Item	Symbol	Test Condition	HD6844			HD68A44			HD68B44			Unit
			min	typ	max	min	typ	max	min	typ	max	
Address Setup Time	$A_0 \sim A_4, R/\bar{W}, \overline{CS}$ t_{AS}	Fig. 2	140	—	—	140	—	—	70	—	—	ns
Address Input Hold Time	$A_0 \sim A_4, R/\bar{W}, \overline{CS}$ t_{AHI}		10	—	—	10	—	—	10	—	—	ns
Data Delay Time	$D_7 \sim D_0$ t_{DDR}		—	—	320	—	—	220	—	—	180	ns
Data Access Time	$D_0 \sim D_7$ t_{ACC}		—	—	460	—	—	360	—	—	280	ns
Data Output Hold Time	$D_0 \sim D_7$ t_{DHR}		10	—	—	10	—	—	10	—	—	ns

2) WRITE TIMING

Item	Symbol	Test Condition	HD6844			HD68A44			HD68B44			Unit	
			min	typ	max	min	typ	max	min	typ	max		
Address Setup Time	$A_0 \sim A_4, R/\bar{W}, \bar{CS}$	t_{AS}	Fig. 2	140	—	—	140	—	—	70	—	—	ns
Address Input Hold Time	$A_0 \sim A_4, R/\bar{W}, \bar{CS}$	t_{AHI}		10	—	—	10	—	—	10	—	—	ns
Data Setup Time	$D_0 \sim D_7$	t_{DSW}		195	—	—	80	—	—	60	—	—	ns
Data Input Hold Time	$D_0 \sim D_7$	t_{DHW}		10	—	—	10	—	—	10	—	—	ns

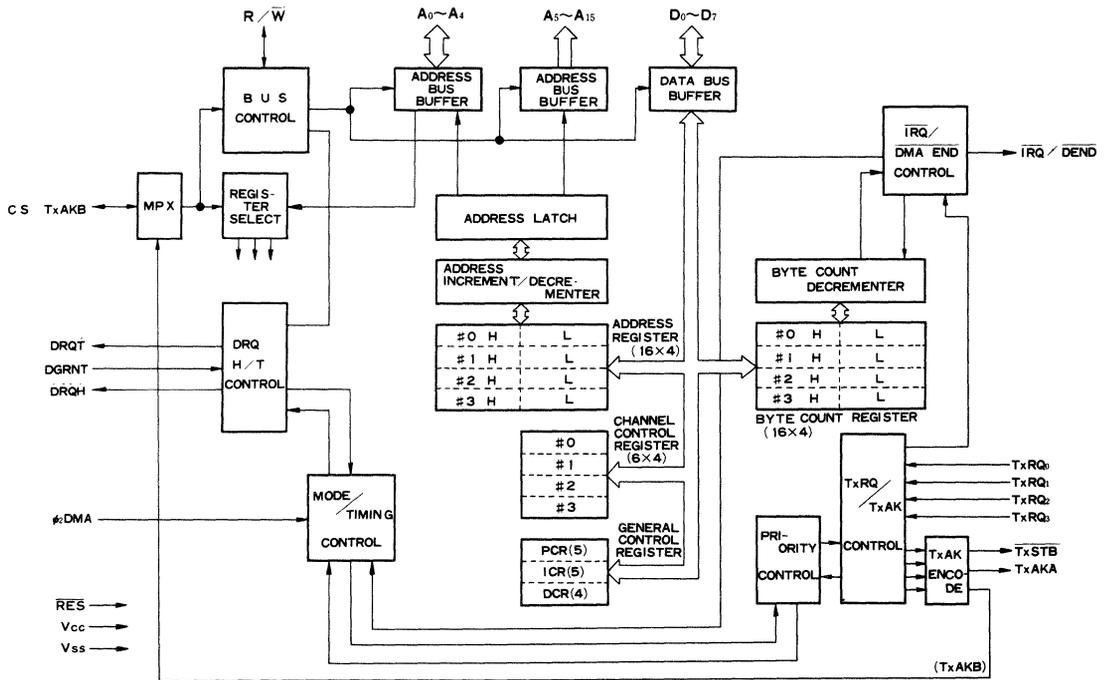


Figure 1 Expanded Block Diagram

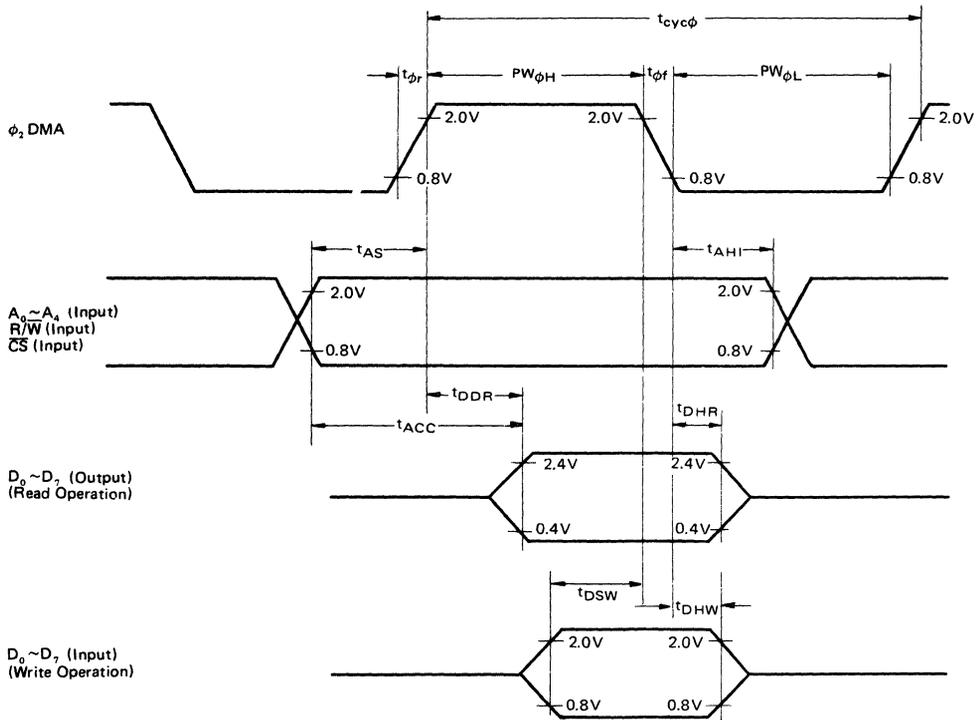


Figure 2 Read/Write Sequence

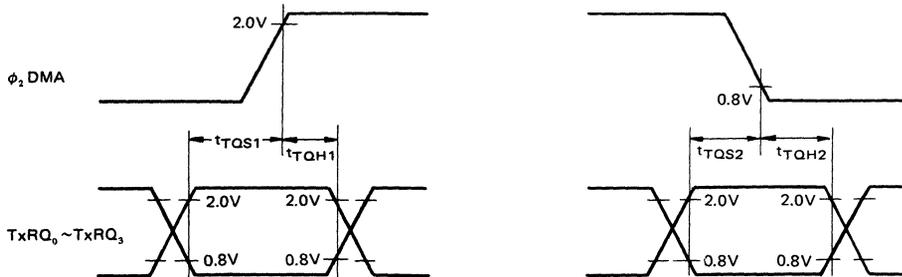


Figure 3 Timing of TxRQ Input

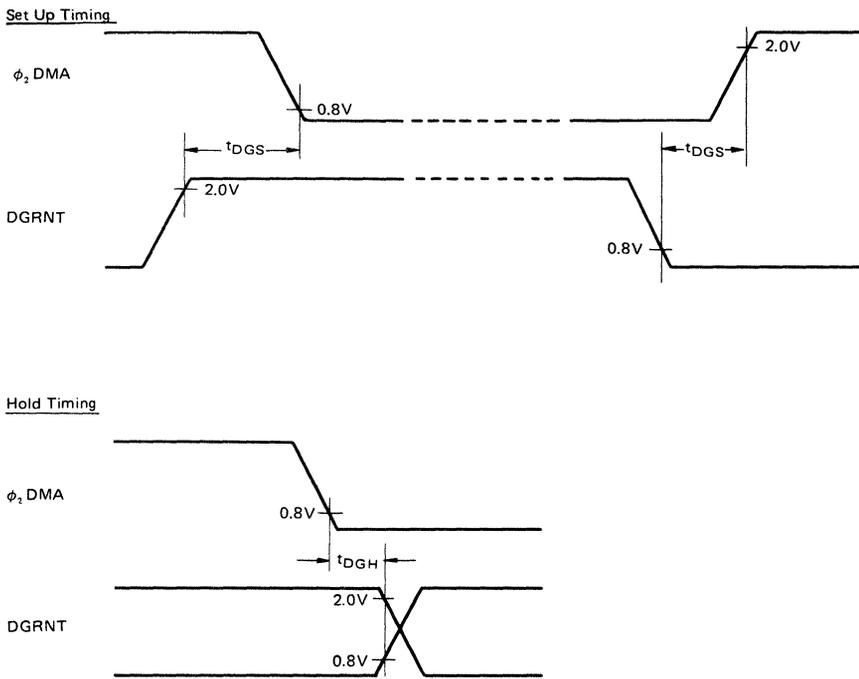


Figure 4 Timing of DGRNT Input

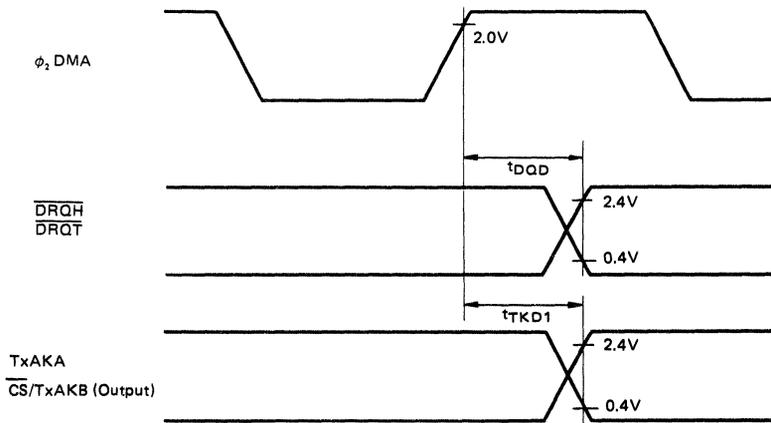


Figure 5 Timing of \overline{DRQH} , \overline{DRQT} , TxAK Outputs

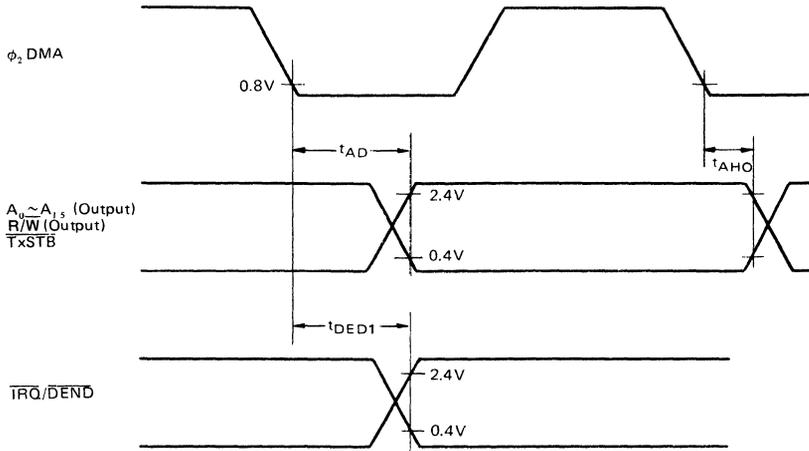
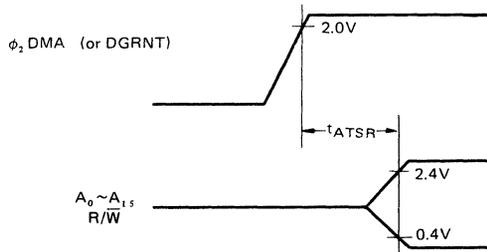


Figure 6 Timing of Address and $\overline{IRQ}/\overline{DEND}$ Outputs

Recovery Time of Address Three-state



Delay Time of Address Three-state

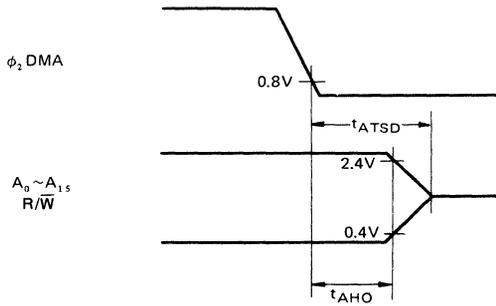


Figure 7 Timing of Address Three-state

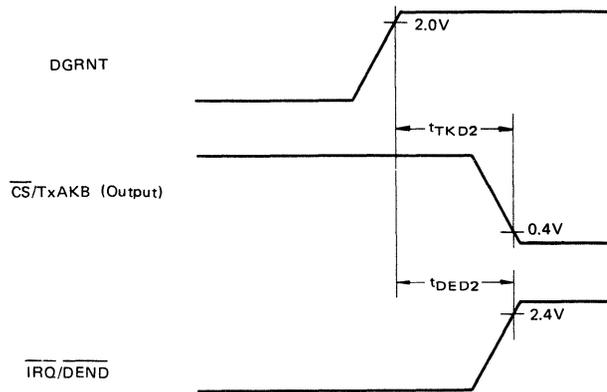
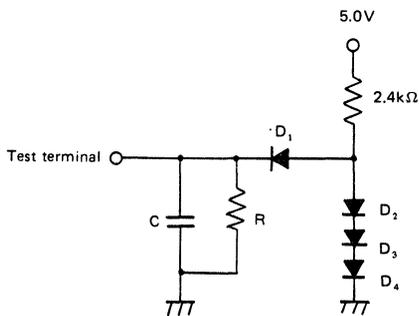


Figure 8 Timing of Synchronous DGRNT Output



Test terminal	C	R
D ₀ ~D ₇	130 pF	11 kΩ
A ₀ ~A ₁₅ , R/W	90 pF	16 kΩ
CS/TxAKB	50 pF	24 kΩ
All other outputs	30 pF	24 kΩ

D₁~D₄ : 1S2074 (H) or equivalent.

Figure 9 Load Circuit

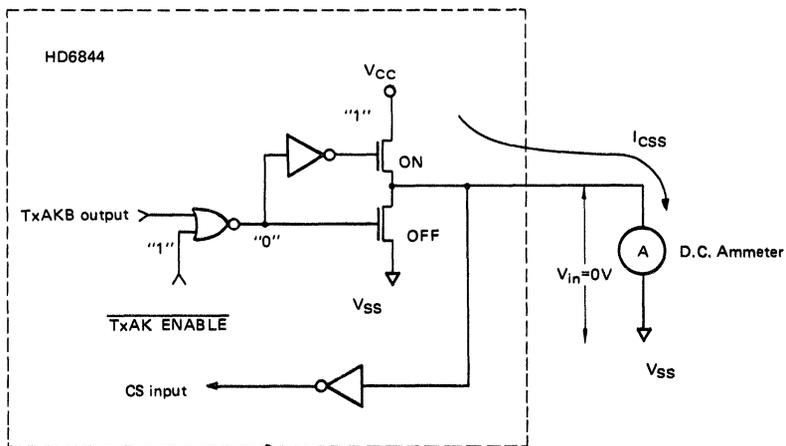


Figure 10 Source Current Measurement Circuit for CS/TxAKB Terminal

■ DEVICE OPERATION

The DMAC has fifteen addressable registers, eight of them are sixteen bits in length. Each channel has a separate Address Register and a Byte Count Register, each of which is sixteen bits. There are also four Channel Control Registers. The three General Control Registers common to all four channels are the Priority Control Register, the Interrupt Control Register, and the Data Chain Register.

To prepare a channel for DMA, the Address Registers must be loaded with the starting memory address and the Byte Count Register loaded with the number of bytes to be transferred. The bits in the Channel Control Register establish the direction of the transfer, the mode, and the address increment or decrement after each cycle. Each channel can be set for one of three transfer modes: Three-State Control (TSC) Steal, Halt Steal, or Halt Burst. Two read-only status bits in the Channel Control Register indicate when the channel is busy transferring data and when the DMA transfer is completed.

The Priority Control Register enables the transfer requests from the peripheral controllers and establishes either a fixed priority or rotating priority scheme of servicing these requests.

When the DMA transfer for a channel is complete (the Byte Count Register is zero), a $\overline{\text{DMA End}}$ signal is directed to the peripheral controller and an $\overline{\text{IRQ}}$ goes to the MPU. Enabling of these interrupts is done in the interrupt Control Register. The $\overline{\text{IRQ}}$ flag bit is read from this register.

Chaining of data transfers is controlled by the Data Chain Register. When enabled, the contents of the Address and Byte Count Registers for channel #3 are put into the registers of the channel selected for chaining when its Byte Count Register becomes zero. This allows for repetitively reading or writing a block of memory.

During the DMA mode, the DMAC controls the address bus and data bus for the system as well as providing the R/W line and a signal to be used as VMA. When a peripheral device controller desires a DMA transfer, it is requested by a Transfer Request. Assuming this request is enabled and meets the test of highest priority, the DMAC will issue a DMA Request. When the DMAC receives the DMA Grant, it gives a Transfer Acknowledge to the peripheral device controller, at which time the data is transferred. When the channel's Byte Count Register equals zero, the transfer is complete and a $\overline{\text{DMA End}}$ is given to the peripheral device controller, and an $\overline{\text{IRQ}}$ is given to the MPU.

● Initialization

During a power-on sequence, the DMAC is reset via the $\overline{\text{RES}}$ input. All registers, with the exception of the Address and Byte Count Registers, are set to a logic "0" state. This disables all requests and the Data Chain function while masking all interrupts. The Address, Byte Count, and Channel Control Registers must be programmed before the respective transfer request bit is enabled in the Priority Control Register.

● Transfer Modes

There are three ways in which a DMA transfer may be done. The one used is determined by the data transfer rate required, the number of channels attached, and the hardware complexity allowable. Refer to Figures 12, 16 and 17.

Two of the modes, TSC Steal and Halt Steal, are done by cycle-stealing from the MPU. The Three-State Control (TSC) Steal mode is initiated by the DMAC bringing the $\overline{\text{DRQT}}$ line "Low". This line goes to the system clock driver which returns a "High" on $\overline{\text{DGRNT}}$ on the rising edge of the system ϕ_1 clock.

The $\overline{\text{DGRNT}}$ signal must cause the address control and data lines to go to the high impedance state. The DMAC now supplies the address from the Address Register of the channel requesting. It also supplies the R/W signal as determined from the Channel Control Register. After one byte is transferred, control is returned to the MPU. This method stretches the ϕ_1 and ϕ_2 clocks while the DMAC uses the memory.

The second method of cycle-stealing is the Halt Steal mode. This method actually halts the MPU instead of stretching the ϕ_1 clock for the transfer period. This mode is initiated by the DMAC bringing the $\overline{\text{DRQH}}$ line "Low". This line connects to the MPU $\overline{\text{HALT}}$ input. The MPU Bus Available (BA) line is the $\overline{\text{DGRNT}}$ input to the DMAC. While the MPU is halted, its Address Bus, Data Bus, and R/W are in the high impedance state. The DMAC now supplies the address and R/W line. After one byte is transferred, the $\overline{\text{HALT}}$ line is returned "High" and the MPU regains control. In this mode, the MPU stops internal activity and is removed from the system while the DMAC uses the memory.

The third mode of transfer is the Halt Burst mode. This mode is similar to the Halt Steal mode, except that the transfer does not stop with one byte. The MPU is halted while an entire block of data is transferred. When the channel's Byte Count Register equals zero, the transfer is complete and control is returned to the MPU. This mode gives the highest data transfer rate, at the expense of the MPU being inactive during the transfer period.

■ INPUT/OUTPUT FUNCTIONS

● DMAC Interface Signals for the MPU

The DMAC interfaces with the HMC56800 MPU through the eight-bit bidirectional data bus, the $\overline{\text{CS}}$ line, five address lines, an $\overline{\text{IRQ}}$ line, the Read/Write line, and the $\overline{\text{RES}}$ line. These signals, in conjunction with the HMC56800 VMA output, permit the MPU to have access to the DMAC. Four other lines associated with the MPU and the clock driver are the $\overline{\text{DRQT}}$, $\overline{\text{DRQH}}$, $\overline{\text{DGRNT}}$, and the ϕ_2 DMA.

Bidirectional Data ($D_0 \sim D_7$)

The Bidirectional Data lines ($D_0 \sim D_7$) allow for data transfer between the DMAC and the MPU. The data bus output drivers are three-state devices that remain in the high impedance state except when the MPU performs DMAC read operations.

Chip Select/Transfer Acknowledge B ($\overline{\text{CS/T}} \times \text{AKB}$)

This line is multiplexed, serving both as an input and an output. $\overline{\text{CS/TxAKB}}$ is an output in the four-channel mode during the DMA transfer. At all other times, it is a high impedance TTL compatible input used to address the DMAC. The DMAC is selected when $\overline{\text{CS/TxAKB}}$ is "Low". VMA must be used in generating this input to insure that false selects will not occur. Transfers of data to and from the DMAC are then performed under the control of the ϕ_2 DMA, Read/Write, and $A_0 \sim A_4$ address lines. In the four-channel mode when TxAKB is needed, the $\overline{\text{CS}}$ gate must have an open-collector output (a pull-up resistor should not be used). In the two-channel mode, $\overline{\text{CS/TxAKB}}$ is always an input.

Address Lines ($A_0 \sim A_4$)

Address lines $A_0 \sim A_4$ are both input and output lines. In the MPU mode, these are high impedance inputs used to address the DMAC registers. In the DMA mode, these lines are outputs which are set to the contents of the Address Register of the channel being processed.

Interrupt Request/DMA End ($\overline{IRQ}/\overline{DEND}$)

$\overline{IRQ}/\overline{DEND}$ is a TTL compatible, active "Low" output that is used to interrupt the MPU and to signal the peripheral controller that the data block transfer has ended. If the Interrupt has been enabled, the $\overline{IRQ}/\overline{DEND}$ line will go "Low" after the last DMA cycle of a transfer. An open collector gate must be connected to DGRNT and $\overline{IRQ}/\overline{DEND}$ to prevent false interrupts from the DEND signal when interrupts are not enabled. Refer to the section of "DMA End Control".

Read/Write (R/\overline{W})

Read/Write is a TTL compatible line that is a high impedance input in the MPU mode and an output in the DMA mode. In the MPU mode, it is used to control the direction of data flow through the DMAC's input/output data bus interface. When Read/Write is "High" (MPU read cycle) and the chip is selected, DMAC data output buffers are turned on and a selected register is read. When it is "Low", the DMAC output drivers are turned off and the MPU writes into a selected register.

In the DMA mode, Read/Write is an output to drive the memory and peripheral controllers. Its state is determined by bit 0 of the Channel Control Register for the channel being serviced. When Read/Write is "High", the memory is read and the data from the memory is written into the peripheral controller. When it is "Low", the peripheral controller is read and its data stored in the memory. In the DMA mode, the DMAC data buffers are off.

Reset (\overline{RES})

The \overline{RES} input provides a means of resetting the DMAC from an external source. In the "Low" state, the \overline{RES} input causes all registers, with the exception of the Address and Byte Count Registers, to be reset to the logic "0" state. This disables all transfer requests, masks all interrupts, disables the data chain function, and puts each Channel Control Register into the condition of memory write, Halt Steal transfer mode, and address increment.

• **Transfer Signals to the MPU**

Two DMA request output lines and a DMA Grant input line, together with the system clock, synchronize the DMAC with the MPU system.

DMA Request Three-State Control Steal (\overline{DRQT})

This active "Low" output requests a DMA transfer for a channel configured for the TSC Steal transfer mode. This line is connected to the system clock driver, requesting a ϕ_1 clock stretch. It will remain in the "Low" state until the transfer has begun.

DMA Request Halt (\overline{DRQH})

This active "Low" output requests a DMA transfer for a channel programmed for the Halt Steal or Halt Burst mode transfer. This line is connected directly to the MPU HALT input and remains "Low" until the last byte has begun to be transferred.

DMA Grant (DGRNT)

This is a high impedance input to the DMAC, giving it control of the system busses. For the TSC Steal mode, the signal comes from the system clock drive circuit (DMA Grant), indicating that the clock is being stretched. For either of the Halt modes, this signal is the Bus Available from the MPU,

indicating that the MPU has halted and turned control of its busses over to the DMAC. For a design involving TSC Steal and Halt mode transfers, this input must be the OR of the clock driven DMA Grant and the MPU BA.

ϕ_2 DMA

Transferring in and out of the DMAC registers, sampling of channel request lines and gating of other control signals to the system is done internally in conjunction with the ϕ_2 DMA high impedance input. This input must be the system memory clock (non-stretched ϕ_2 clock).

• **Transfer Signals From the Peripheral Controller**

Transfer Request ($TxRQ_0 \sim TxRQ_3$)

Each of the four channels has its own high impedance input request for transfer line. The peripheral controller requests a transfer by setting its TxRQ line "High" (a logic "1"). The lines are sampled according to the priority and enabling established in the Priority Control Register. In the Steal mode and the first byte of the Halt Burst mode, the TxRQ signals are tested on the positive edge of ϕ_2 DMA and the highest priority channel is strobed. Once strobed, the TxRQs are not tested until that channel's data transfer is finished. In the succeeding bytes of the Halt Burst mode transfer, the TxRQ is tested on the negative edge of ϕ_2 DMA, and data is transferred on the next ϕ_2 DMA cycle if TxRQ is "High".

• **Transfer Signals to the Peripheral Controller**

Two encoded lines select the channel to be serviced. A strobe line acknowledges the request and performs the transfer. The \overline{DEND} line signals to the peripheral controller that the DMA transfer is completed.

Transfer Acknowledge A ($TxAKA$)

The Transfer Acknowledge A ($TxAKA$) is a TTL compatible output used in conjunction with the $\overline{CS}/TxAKB$ line to select the channel to be strobed for transfer and to give the DMA End Signal. In the two-channel mode, only TxAKA is used to select channel 0 or channel 1, and $\overline{CS}/TxAKB$ is always an input.

Chip Select/Transfer Acknowledge B ($\overline{CS}/TxAKB$)

In the DMA mode, this dual purpose line is encoded together with TxAKA to select the channel being serviced. Table 1 shows the encoding order.

Table 1 Encoding Order

$\overline{CS}/TxAKB$	TxAKA	Channel #
0	0	0
0	1	1
1	0	2
1	1	3

Transfer Strobe (\overline{TxSTB})

The \overline{TxSTB} causes acknowledgement to be given to the peripheral controller and transfers the data to or from the memory. This line is also intended to be the VMA signal for the system in the DMA mode. In a one-channel system, \overline{TxSTB} may be inverted and run to the peripheral controller's Acknowledge input. In a two or four-channel system, \overline{TxSTB} enables the decode of TxAKA and $\overline{CS}/TxAKB$ to select the device controller to be acknowledged.

Interrupt Request/DMA End ($\overline{IRQ}/\overline{DEND}$)

In the DMA mode, this dual purpose line is "Low" for the last byte of transfer, indicating a DMA End. This occurs when the Byte Count register decrements to zero.

This line, through the decode of \overline{TxAKA} and $\overline{CS}/\overline{TxAKB}$, can be used to strobe a DMA End to each device controller.

- **Address Lines to the Memory**

Address Lines ($A_0 \sim A_{15}$)

These output lines are in the high impedance state during the MPU mode. In the DMA mode, these lines are outputs which are set to the contents of the Address Register of the channel being processed.

- **THE DMAC REGISTERS**

The HD6844 (DMAC) has Address Register (ADR), Byte Count Register (BCR), Channel Control Register (CHCR), and General Control Register (GCR).

General Control Register (GCR) is composed of Priority Control Register (PCR) that controls priority among the chan-

nels, Interrupt Control Register (ICR) that controls interrupt and Data Chain Control Register (DCR) that controls data chain function. Refer to Table 2 and Figure 1.

These are Read/Write registers and MPU can exchange the data with DMAC when \overline{CS} is at "Low" level. $A_0 \sim A_4$ specifies the address of the registers. How to specify the registers is shown in Table 2.

2-byte ADR and BCR can be read or written by one instruction, using 2-byte instruction of the MPU.

- **Function of Internal Registers**

ADR (Address Register)

Each channel has 16-bit Address Register. Initial address of memory used for DMA transfer is programmed to this register. The contents of ADR are output to address bus ($A_0 \sim A_{15}$) during DMA transfer operation. When 1-byte transfer has completed, the 16-bit address is incremented or decremented by one.

The address which the MPU reads out is the renewed one, that is, the memory address for the next transfer. When 1-block transfer has completed, final memory address +1 is read out.

Table 2 Internal Registers of the DMAC

Register Name	Symbol	Channel	Address Bus Signal					Address (Hexadecimal)
			A_4	A_3	A_2	A_1	A_0	
Address Register	ADRH	0	0	0	0	0	0	00
	ADRL	0	0	0	0	0	1	01
Byte Count Register	BCRH	0	0	0	0	1	0	02
	BCRL	0	0	0	0	1	1	03
Address Register	ADRH	1	0	0	1	0	0	04
	ADRL	1	0	0	1	0	1	05
Byte Count Register	BCRH	1	0	0	1	1	0	06
	BCRL	1	0	0	1	1	1	07
Address Register	ADRH	2	0	1	0	0	0	08
	ADRL	2	0	1	0	0	1	09
Byte Count Register	BCRH	2	0	1	0	1	0	0A
	BCRL	2	0	1	0	1	1	0B
Address Register	ADRH	3	0	1	1	0	0	0C
	ADRL	3	0	1	1	0	1	0D
Byte Count Register	BCRH	3	0	1	1	1	0	0E
	BCRL	3	0	1	1	1	1	0F
Channel Control Register	CHCR	0	1	0	0	0	0	10
	CHCR	1	1	0	0	0	1	11
	CHCR	2	1	0	0	1	0	12
	CHCR	3	1	0	0	1	1	13
Priority Control Register	PCR	—	1	0	1	0	0	14
Interrupt Control Register	ICR	—	1	0	1	0	1	15
Data Chain Control Register	DCR	—	1	0	1	1	0	16

- (NOTE) 1) All the registers can be accessed by R/W operation. Unused bit of the register is read out "0".
 2) H/L of ADR and BCR means the higher (H) 8 bits/the lower (L) 8 bits of a 16-bit register.
 3) 16-bit ADR and BCR can be read or written by one instruction, using MPU's 2-byte LOAD/STORE instruction.

Register Address
 e.g. LDX $\$_{*}0C$ [(ADR H) → (Index Register H)]
 Address of DMAC [(ADR L) → (Index Register L)]

BCR (Byte Count Register)

Each channel has a 16-bit Byte Count Register. Number of DMA transfer words is programmed into this register. The content of the Byte Count Register is decremented by one everytime one-byte transfer has completed. When it becomes "0", DEND output goes "Low" level and informs I/O controller of the end of one-block DMA transfer. When IRQ is not masked, IRQ output goes "Low" level and MPU is interrupted to be informed of the end of DMA transfer. Moreover, IRQ and DEND signals are output, multiplexed with IRQ/DEND pin.

CHCR (Channel Control Register)

Each channel has Channel Control Register. This register is

used to program the control information of its corresponding channel. Structure of CHCR is shown in Table 3.

- (1) R/W Control (specifies the direction of transfer)
Bit – CHCR Bit 0

This bit controls the direction of DMA transfer. When it is at "1", R/W signal of DMAC goes "High" level during DMA transfer operation. This means to read out memory and write into I/O controller, that is, data is transferred from memory to I/O controller.

When it is at "0", R/W output goes "Low" level and data is transferred from I/O controller to memory.

Table 3 Bit Structure of CHCR (Channel Control Register)

Bit No.	Name	R/W	Function	
			"1"	"0"
0	R/W	R/W	Transfer from memory to I/O controller (R/W output = "High")	Transfer from I/O controller to memory (R/W output = "Low")
1	Burst/Cycle Steal	R/W	Burst Mode	Cycle Steal Mode*
2	TSC/HALT	R/W	TSC Mode	HALT Mode*
3	Address down/up	R/W	Address: -1	Address: +1
4	Not used	—	—	—
5	Not used	—	—	—
6	Busy/Ready Flag	R	Busy (DMA Transfer Operation)	Ready (No DMA Transfer Operation)
7	DEND Flag	R	DMA End & Interrupt	No Interrupt

* Burst•TSC mode is prohibited.

Note that during DMA transfer operation, the function of R/W signal is accommodated to the memory Read/Write operation. Therefore, on the side of I/O device during DMA transfer operation, R/W input should be interpreted in inverse of the MPU Read/Write. That is, data should be output when R/W input is at "Low" level (In the case of MPU's read operation, I/O device outputs the data when it is at "High" level).

This arises from that during DMA transfer operation, I/O side performs data transfer independently instead of MPU. Moreover, such family LSI as HD6843 (FDC), etc. has this function and R/W signal is automatically interpreted inversely.

- (2) Burst/Cycle Steal Bit – CHCR Bit 1

This bit is used to decide that DMA transfer should be performed in burst mode or cycle steal mode. When it is at "1", it specifies burst mode. That is, once DMA transfer is performed, MPU remains stopped until one-block data transfer is completed.

When this bit is "0", it specifies cycle steal mode. That is, everytime one-byte transfer has completed, MPU takes back the bus control, and DMA transfer and MPU operation are performed in time sharing.

(NOTE) Only in the case of HALT mode, burst mode can be specified. When TSC mode is specified, burst mode cannot be specified.

- (3) TSC/HALT Mode Bit – CHCR Bit 2

This bit is used to decide that DMA transfer should be

performed by using MPU's TSC function or HALT function. When it is at "0", DRQH output of DMAC is connected to HALT input of MPU and DMA transfer is performed by using MPU's HALT function.

When it is at "1", DMA transfer is performed by using MPU's TSC function. That is, DRQT output is connected to HD26501 (CPG) and MPU's clock ϕ_1 is extended. Then MPU's TSC input becomes "High" level and the bus gets into high impedance state to perform DMA transfer.

- (4) Address down/up Bit – CHCR Bit 3

This bit is used to decide that the address of memory region used for DMA transfer should be renewed up (increment of address) or down (decrement of address). When it is at "1", the address is decremented by one after one-byte transfer. When it is at "0", the address is incremented by one.

- (5) Busy/Ready Flag Bit – CHCR Bit 6

This bit is a status flag to indicate whether its corresponding channel is performing DMA transfer or not. (READ only)

When it receives the first TxRQ of its corresponding channel, it goes to "1". When one-block transfer is completed and BCR becomes "0", it is reset to "0".

Also this flag is cleared when corresponding TxRQ Enable Bit in the PCR becomes "0".

- (6) DEND Flag Bit – CHCR Bit 7

This bit is an interrupt flag to indicate that one-block DMA transfer of its corresponding channel has completed.

(READ only).

When one-block transfer of its corresponding channel is completed and BCR becomes "0", it goes to "1". As soon as this flag is read out, i.e. CHCR of this channel is read out, it is reset to "0".

Moreover, this bit is connected to $\overline{\text{IRQ}}$ output. When it is at "1" and IRQ enable bit (within ICR register described

later) is at "1", $\overline{\text{IRQ}}$ output goes "Low" level.

PCR (Priority Control Register)

Priority Control Register is a 5-bit register to decide the operation mode of priority control circuit. Structure of PCR is shown in Table 4.

Table 4 Bit Structure of PCR (Priority Control Register)

Bit No.	Name	R/W	Function	
			"1"	"0"
0	TxRQ Enable #0 (TxEN ₀)	R/W	TxRQ of Channel 0 is accepted.	TxRQ of Channel 0 is not accepted.
1	TxRQ Enable #1 (TxEN ₁)	R/W	TxRQ of Channel 1 is accepted.	TxRQ of Channel 1 is not accepted.
2	TxRQ Enable #2 (TxEN ₂)	R/W	TxRQ of Channel 2 is accepted.	TxRQ of Channel 2 is not accepted.
3	TxRQ Enable #3 (TxEN ₃)	R/W	TxRQ of Channel 3 is accepted.	TxRQ of Channel 3 is not accepted.
4	} Not used	—	—	—
5		—	—	—
6		—	—	—
7	Rotate Control	R/W	Rotate Mode	The order of priority is fixed at numerical order.

(1) TxRQ Enable Bit (TxEN₀~TxEN₃) – PCR Bit 0~3

Each channel has this TxRQ Enable bit. When it is at "1", TxRQ input of its corresponding channel is accepted to perform DMA transfer. When it goes to "0", TxRQ of its corresponding channel is masked not to be received and TxAK is not output. During DMA transfer operation, when this bit goes to "0" before BCR becomes "0", following TxRQ input is not accepted and DMA transfer is interrupted. Then contents of ADR and BCR remain unchanged. When it rises to "1" again, DMA transfer is reopened. Therefore, in the case of cycle steal DMA, it is possible for the program to change the priority of the specific channel temporarily by manipulating this bit.

(2) Rotate Control Bit – PCR Bit 7

When this bit is at "0", the order of priority among DMA channels is fixed at numerical order. That is, Channel 0 is given a first priority and then is followed by Channel 1 → 2 → 3.

When this bit is at "1", priority control is due to rotate mode. That is, the channel that ended in the first time is given a first priority and the channel ended in the last time is controlled to be given a last priority.

ICR (Interrupt Control Register)

Interrupt Control Register is a 5-bit register to control $\overline{\text{IRQ}}$ output. Its structure is shown in Table 5.

(1) IRQ Enable Bit – ICR Bit 0~3

Each channel has IRQ Enable Bit. When this bit is at "1" and DEND Flag of its corresponding channel is set to "1", $\overline{\text{IRQ}}$ output goes "Low" level. But when it is at "0", $\overline{\text{IRQ}}$ output is masked not to be output even if DEND Flag is set to "1".

These bits enable to control to output only a necessary channel to $\overline{\text{IRQ}}$.

(2) IRQ Flag – ICR Bit 7

This is a read-only bit and the status of $\overline{\text{IRQ}}$ output is directly reflected on it. That is, when $\overline{\text{IRQ}}$ output goes to "Low" level, it becomes "1".

$\overline{\text{IRQ}}$ output of DMAC is output as logical OR of 4-channel DEND Flag according to the following equation.

$$\overline{\text{IRQ}} = (\text{DEND}_0 \cdot \text{IRQ Enable}_0) + (\text{DEND}_1 \cdot \text{IRQ Enable}_1) + (\text{DEND}_2 \cdot \text{IRQ Enable}_2) + (\text{DEND}_3 \cdot \text{IRQ Enable}_3)$$

DCR (Data Chain Control Register)

Data Chain Control Register is a 4-bit register and three of those bits are used to control data chain function. Remaining one bit is used to specify 2-channel/4-channel mode.

Structure of DCR is shown in Table 6.

(1) Data Chain Enable Bit – DCR Bit 0

When this bit is at "1", data chain function of DMAC is enabled. That is, when DMA transfer of a specified channel has completed and BCR goes to "0", the contents of ADR and BCR of Channel #3 are automatically transferred to ADR and BCR of the specified channel.

(2) Data Chain Channel Bit – DCR Bit 1~2

These bits are used to specify which channel should be used for the data chain. How to specify the channel is shown in Table 7. Data Chain Channel bit specifies the channel to which data should be transferred from Channel #3. Channel #3 contains the data for replacement. Channel #3 is fixed and cannot be changed.

(3) 2/4-channel Mode Bit – DCR Bit 3

This bit has no relation to the data chain function.

It is used to specify whether $\overline{\text{CS}}$ /TxAKB is used for only input pin or I/O pin. When this bit is "0", $\overline{\text{CS}}$ /TxAKB becomes $\overline{\text{CS}}$ input pin in 2-channel mode since TxAKB output is not necessary for application up to 2-channel.

When this bit is "1", $\overline{\text{CS}}$ /TxAKB becomes I/O pin in 4-channel mode (See Fig. 11).

Table 5 ICR (Interrupt Control Register)

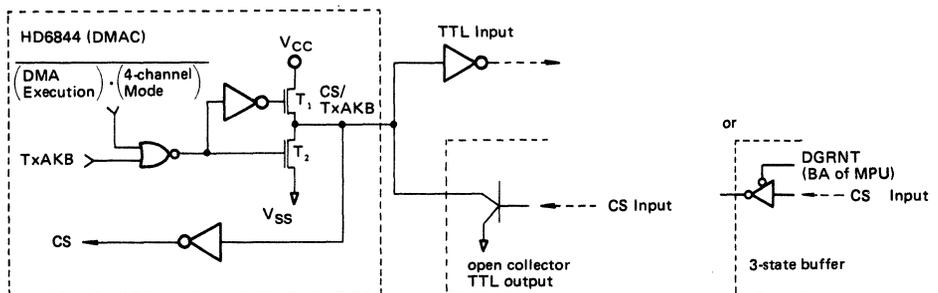
Bit No.	Name	R/W	Function	
			"1"	"0"
0	IRQ Enable #0	R/W	$\overline{\text{IRQ}}$ of Channel 0 is able to be output.	$\overline{\text{IRQ}}$ output of Channel 0 is masked.
1	IRQ Enable #1	R/W	$\overline{\text{IRQ}}$ of Channel 1 is able to be output.	$\overline{\text{IRQ}}$ output of Channel 1 is masked.
2	IRQ Enable #2	R/W	$\overline{\text{IRQ}}$ of Channel 2 is able to be output.	$\overline{\text{IRQ}}$ output of Channel 2 is masked.
3	IRQ Enable #3	R/W	$\overline{\text{IRQ}}$ of Channel 3 is able to be output.	$\overline{\text{IRQ}}$ output of Channel 3 is masked.
4	Not used	—	—	—
5		—	—	—
6		—	—	—
7	IRQ Flag	R	$\overline{\text{IRQ}}$ output "Low"	$\overline{\text{IRQ}}$ output "High" (off state)

Table 6 Bit Structure of DCR (Data Chain Control Register)

Bit No.	Name	R/W	Function	
			"1"	"0"
0	Data Chain Enable	R/W	Data Chain is performed.	Data Chain is not performed.
1	Data Chain Channel	R/W	The channel which performs Data Chain is specified. (The channel where contents of ADR and BCR of Channel #3 are loaded.)	
2		R/W		
3	2/4-Channel Mode	R/W	4-Channel Mode (CS/TxAkB is I/O pin.)	2-Channel Mode (CS/TxAkB is designated to only input pin.)
4	Not used	—	—	—
5		—	—	—
6		—	—	—
7		—	—	—

Table 7 How to specify Data Chain Channel

DCR Bit 1	DCR Bit 2	Specified Channel
0	0	Channel #0
1	0	Channel #1
0	1	Channel #2
1	1	—



In $\overline{\text{CS}}$ input mode T1 turns ON and T2 turns OFF. T1 functions as pull-up resistance.

Figure 11 How to Use CS/TxAkB Pin

■ OPERATION OF THE DMAC

● Transfer Mode of the DMAC

There are three DMA transfer modes such as HALT Cycle Steal, HALT Burst and TSC Cycle Steal. Operation in each mode is explained in the following.

HALT Cycle Steal Mode

This is a basic DMA transfer mode. In this mode, everytime 1-byte transfer has completed, MPU takes back the bus control and executes Instruction cycle. That is, DMA transfer and MPU operation are performed in time sharing.

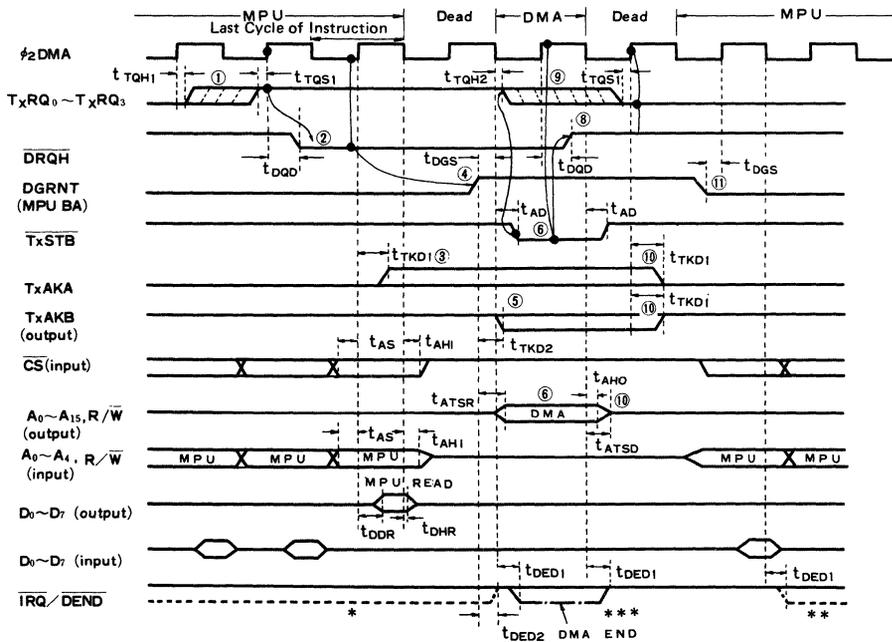
Timing chart is shown in Fig. 12 and flow chart is shown in Fig. 13. Procedure of transfer operation is the following. (No. ① ~ ⑪ in Fig. 12 correspond to the following items.)

- ① TxRQ₀~TxRQ₃ input is checked at the rising edge of ϕ_2 DMA. When it is at "High" level, it gets into the following operation.
- ② \overline{DRQH} ="Low" is output and MPU is requested to stop its operation.
- ③ TxAKA is driven (Level output).
- ④ MPU stops its operation and DMAC waits until DGRNT goes to "High" level.
- ⑤ When DGRNT goes to "High" level, DMAC drives TxAKB, A₀~A₁₅ and R/ \overline{W} lines.
- ⑥ \overline{TxSTB} is given to perform DMA transfer.
- ⑦ Address is incremented by one and number of transfer words is decremented by one.

- ⑧ When \overline{DRQH} rises to "High" level, MPU gets into Instruction Cycle again.
- ⑨ TxRQ falls to "Low" level.
- ⑩ A₀~A₁₅ and R/ \overline{W} get into high impedance state again.
- ⑪ DGRNT falls to "Low" level.

[Note] TxRQ₀~TxRQ₃ input is, in principle as shown in Fig. 12, set to "High" on account of I/O request. When \overline{TxSTB} of the DMAC is driven, it is reset to "Low". Take care not to be against this principle, or the following states may happen.

- (1) In the case where TxRQ becomes "High", but it is reset to "Low" before DGRNT becomes "High". In this case, the DMAC is in the wait state without sending out \overline{TxSTB} until TxRQ rises to "High" again. As \overline{DRQH} remains "Low" the MPU is forced to be stopped, and the system is in dead lock state until TxRQ rises to "High" again (Fig. 14).
- (2) In the case where TxRQ is not reset to "Low" though \overline{TxSTB} has been driven. In this case, unless TxRQ returns to "Low" by the time ϕ_2 DMA rises after \overline{TxSTB} has risen to "High", it is considered as a new I/O request, which leads the above-mentioned operation ①, ② → If TxRQ falls to "Low" immediately after that, the same state as (1) happens (Fig. 15).



* \overline{IRQ} of another channel or its own \overline{IRQ} (remaining)
 ** Its own \overline{IRQ} (output) or its own \overline{IRQ} (remaining) or \overline{IRQ} of another channel
 *** This is the last cycle of transfer

Figure 12 HALT Cycle Steal Mode



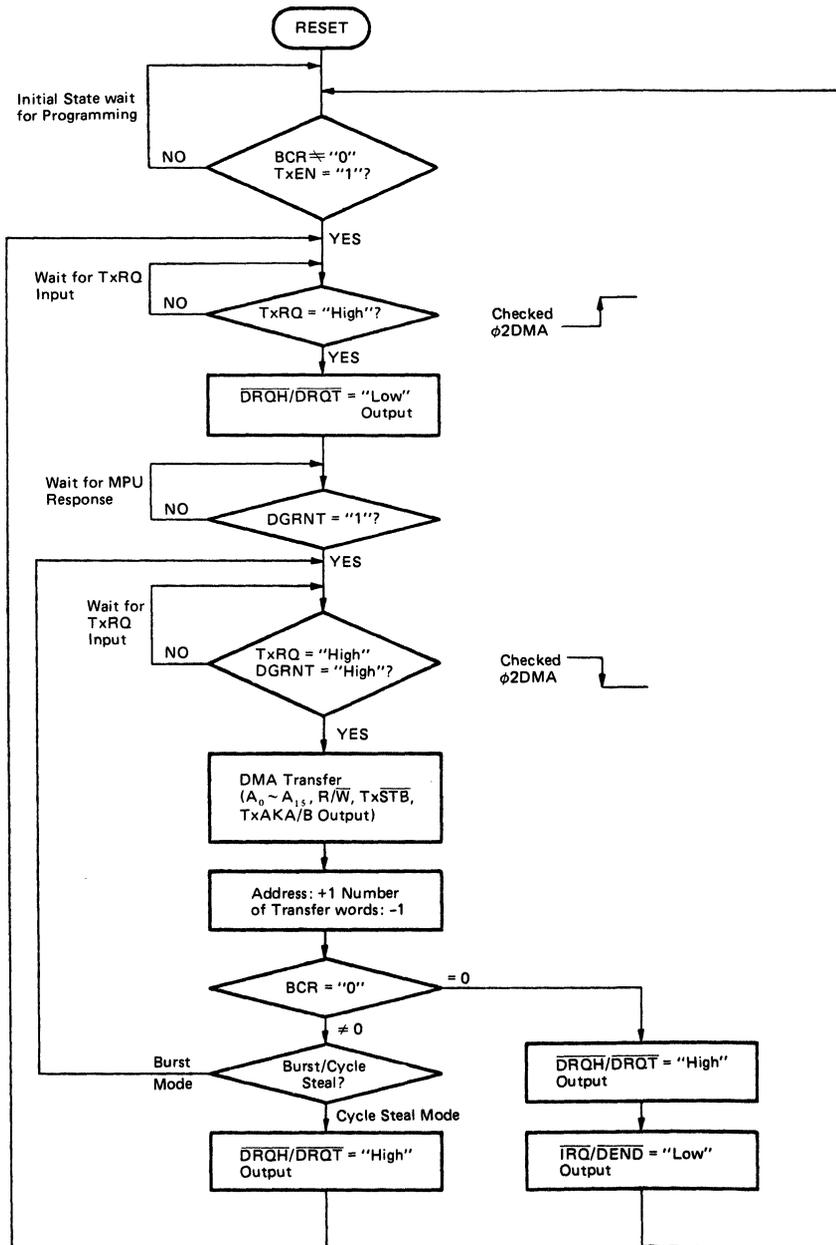


Figure 13 Flow Chart of DMAC Operation

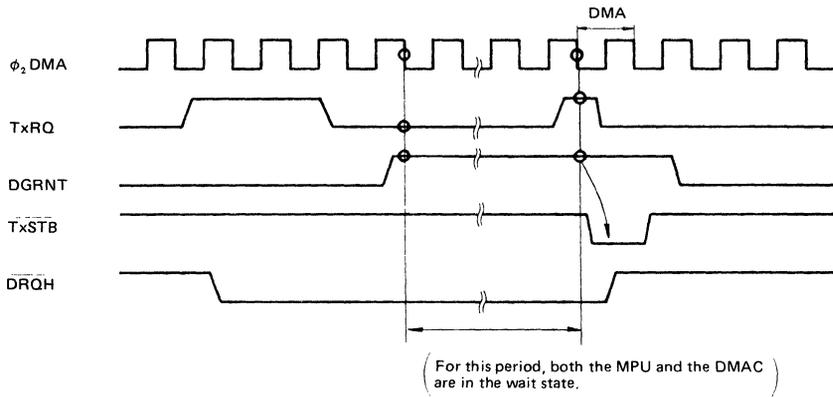


Figure 14 Extraordinary TxRQ Input (1)

(In the case where TxRQ is reset to "Low" before the transfer)

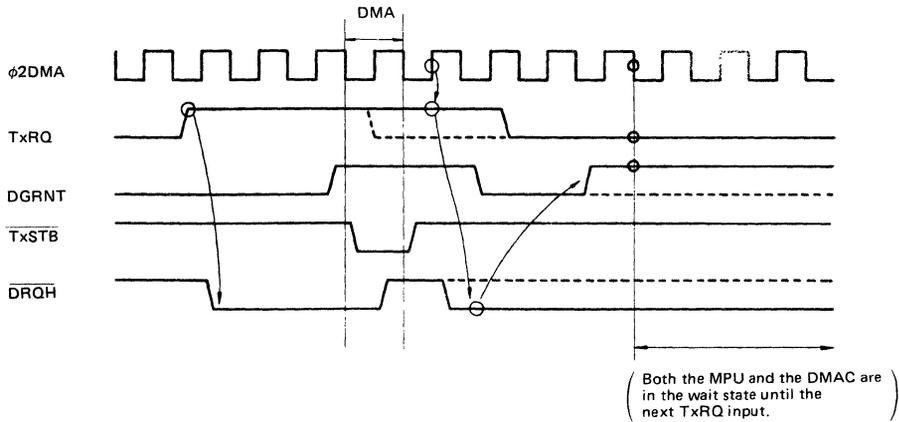


Figure 15 Extraordinary TxRQ Input (2)

(In the case where TxRQ doesn't fall to "Low" after the transfer has been completed.)

HALT Burst Mode

In the case of cycle steal mode, MPU gets into Instruction Cycle everytime 1-byte transfer has completed. But in the case of burst mode, MPU remains stopped until 1-block transfer is finished. That is, \overline{DRQH} continues to be output "Low" level until BCR becomes "0".

Its timing chart and flow chart are shown in Fig. 16 and Fig. 13 respectively. Procedure of transfer is the following (No. ① ~ ⑭ in Fig. 16 correspond to the following items).

- ① TxRQ input is checked at the rising edge of ϕ_2 DMA. When it is at "High" level, it gets into the following operation.
- ② \overline{DRQH} ="Low" level is given and MPU is requested to stop its operation.
- ③ TxAKA is driven.
- ④ MPU stops and DMAC waits for DGRNT rising "High" level.
- ⑤ When DGRNT rises "High" level, DMAC drives TxAKB, $A_0 \sim A_{15}$, and R/ \overline{W} lines.
- ⑥ \overline{TxSTB} is sent out to perform DMA transfer.
- ⑦ Address is incremented by one and number of transfer words is decremented by one.
- ⑧ TxRQ falls to "Low" level.
- ⑨ When number of transfer words is 0, from ⑪ to ⑭ operations are performed.

- ⑩ When BCR is not "0", TxRQ is checked at the falling edge of ϕ_2 DMA. When TxRQ is at "High" level, DMA transfer is performed through ⑥ ~ ⑧ again. When TxRQ is not at "High" level, DMAC waits for becoming "High" level.
- ⑪ $\overline{IRQ/DEND}$ output goes to "Low" level.
- ⑫ \overline{DRQH} output rises to "High" level and MPU gets into Instruction Cycle again.
- ⑬ $A_0 \sim A_{15}$ and R/ \overline{W} get into high impedance state.
- ⑭ DGRNT falls to "Low" level.

The transfer of the first byte (① ~ ⑥) is performed in the same way as that in cycle steal mode. But in the second-byte and subsequent transfer, TxRQ is checked at the falling edge of ϕ_2 DMA and if TxRQ is at "High" level, DMA transfer is performed at the following cycle. Therefore, a high-speed response (MAX. 1 byte/1 cycle) is feasible.

In burst mode, TxRQ should be also, in principle, set to "High" when I/O request is asserted, and reset to "Low" when \overline{TxSTB} goes to "Low". If TxRQ is asserted as level input without being reset, DMA transfer is performed at all cycles of ϕ_2 DMA since TxRQ is always at "High" level at the falling edge of ϕ_2 DMA. Its example is shown in the second-byte and the third-byte transfer in Fig. 16.

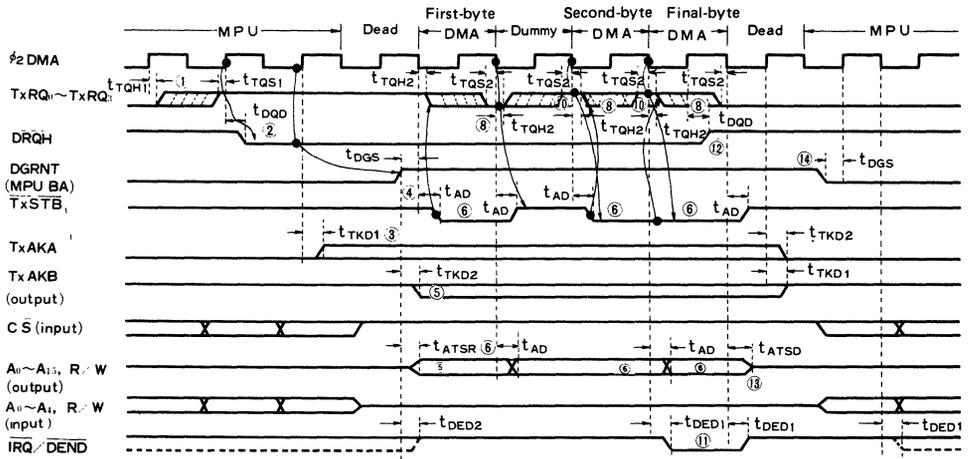


Figure 16 HALT Burst Mode

TSC Cycle Steal Mode

In the above-mentioned modes, DMA is performed by using the HALT function of the MPU. In TSC cycle steal mode, DMA is performed by using the TSC function of the MPU.

Its timing chart and flow chart are shown in Fig. 17 and Fig. 13 respectively.

Basic operation of the DMAC is the same as that in HALT cycle steal mode, but the detailed timing is different. The difference is explained in the following.

- (1) \overline{DRQT} is used instead of \overline{DRQH} .
- (2) \overline{DRQT} is connected to the CPG instead of the MPU. When \overline{DRQT} goes to "Low", MPU (ϕ_1, ϕ_2) clock gets into an extended state.

- (3) DGRNT is connected to DGRNT of the CPG. DGRNT timing is different from that in HALT mode. (DGRNT is connected to BA of the MPU.) (The response time is quick. It is set at half-clock before BA and is reset at 1-clock before BA.)

More detailed timing of DGRNT of the CPG shall be shown in the manual of the CPG.

In TSC mode, there isn't a burst mode. Because the MPU clock cannot be extended for a long time. When TSC mode is specified, \overline{DRQT} returns to "High" and the MPU gets into the Instruction Cycle everytime 1-byte transfer has finished.

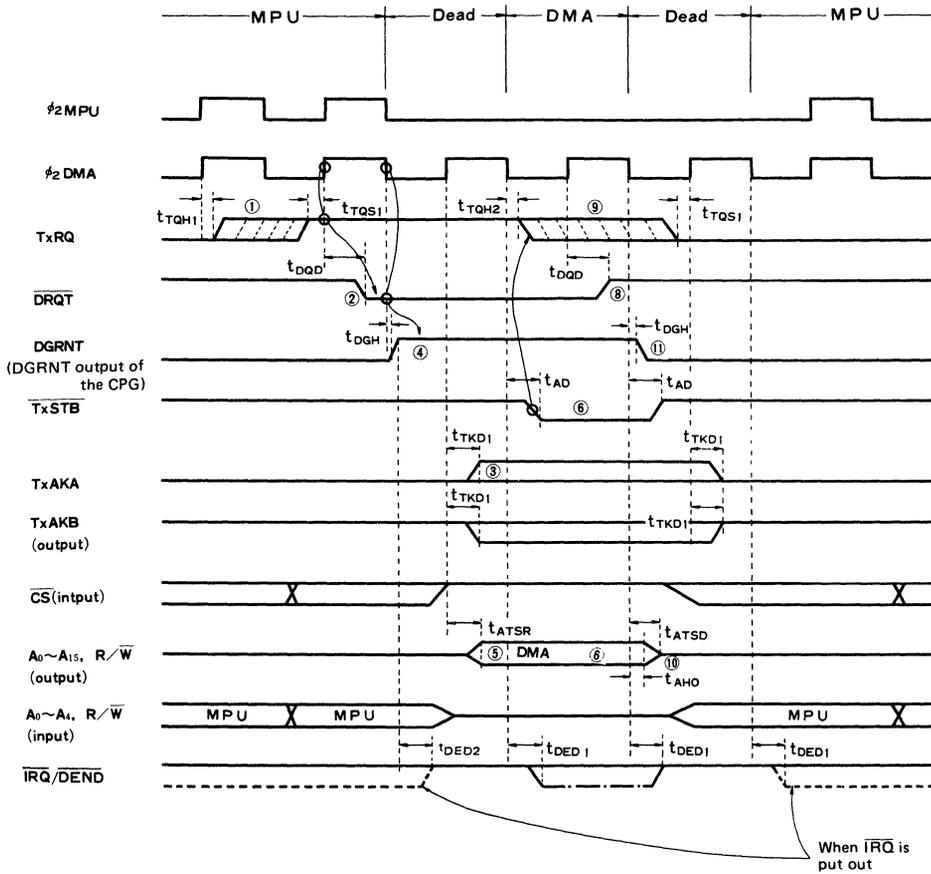


Figure 17 TSC Cycle Steal Mode

● Priority Control
Basic priority Control

There are two kinds of the DMAC priority control function. One is to mask TxRQ on each channel by TxRQ Enable bit. The other is priority-order-determining-circuit which the DMAC has as a hardware.

Moreover, the priority-order-determining-circuit has two operation modes (the rotate mode and the normal mode).

Structure of the priority control circuit is shown in Fig. 18. As shown in Fig. 18, TxRQ of the channel whose TxRQ Enable bit is at "1" level becomes an input of the priority-order-determining-circuit. Then it is checked whether TxRQ is at "High" level or not.

(Note) In this case, ZERO flag needs to be at "1" level. ZERO flag will be described later.

If one of TxRQ₀~TxRQ₃ is at "High" level, its channel is selected, being given a first priority. Then it is latched by an executing-channel-number-latch-circuit to perform DMA transfer. Once an executing channel is determined and latched, it is unchanged until its DMA transfer has been completed. That is, the channel number strobe signal doesn't go to "1" and the contents of the channel-number-latch-circuit are unchanged. In the cycle steal mode, the channel is fixed until 1-byte transfer has completed. In the burst mode, it is fixed until BCR becomes "0".

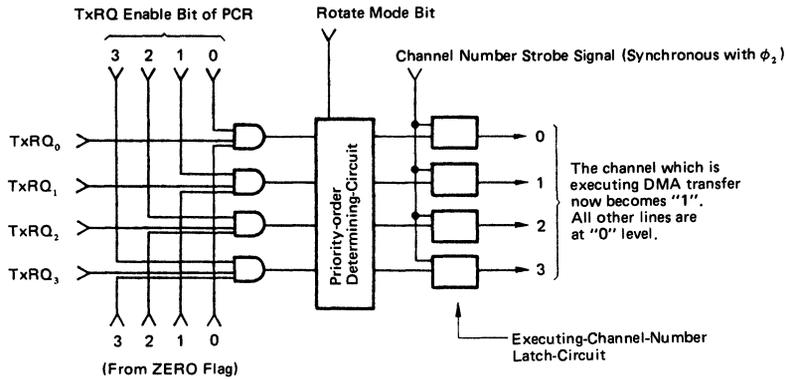


Figure 18 Structure of Priority Control Circuit

Therefore, once a long-period DMA transfer of a channel is performed in the burst mode, other channels need to wait until it has completed even if they have higher priority than the channel. Take much care to this point in designing response time to TxRQ of DMA channel.

(Note) As explained above, TxRQ input is latched internally. So

once it is accepted and latched, the channel number cannot be changed even though it returns to "Low". But as explained in HALT Cycle Steal Mode, DMA transfer is not performed unless TxRQ rises to "High" again.

Strobe timing of executing-channel-number-latch-circuit is shown in Fig. 19.

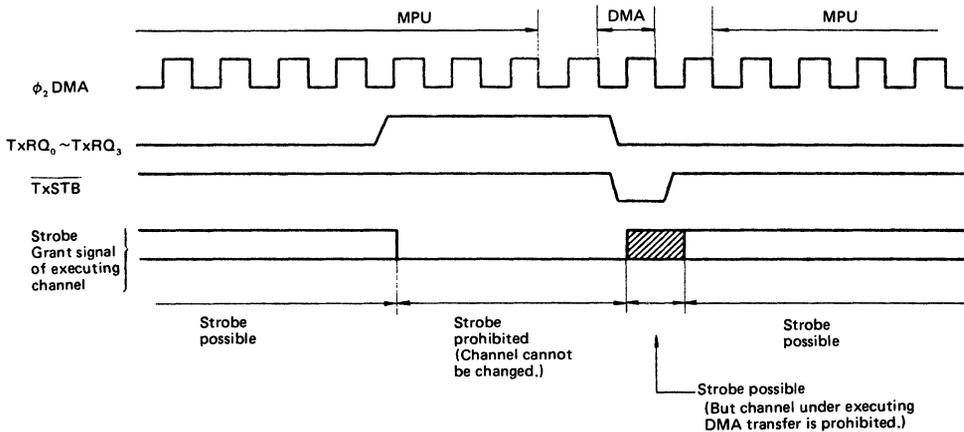


Figure 19 Strobe Timing of Executing-Channel-Number-Latch-Circuit (the cycle steal mode)

But, as shown in Fig. 19, only the channel under executing DMA transfer is prohibited to accept TxRQ during DMA transfer operation, in order that one more byte transfer may not be

performed when the reset timing of TxRQ is delayed. Strobe timing in the burst mode is shown in Fig. 20.

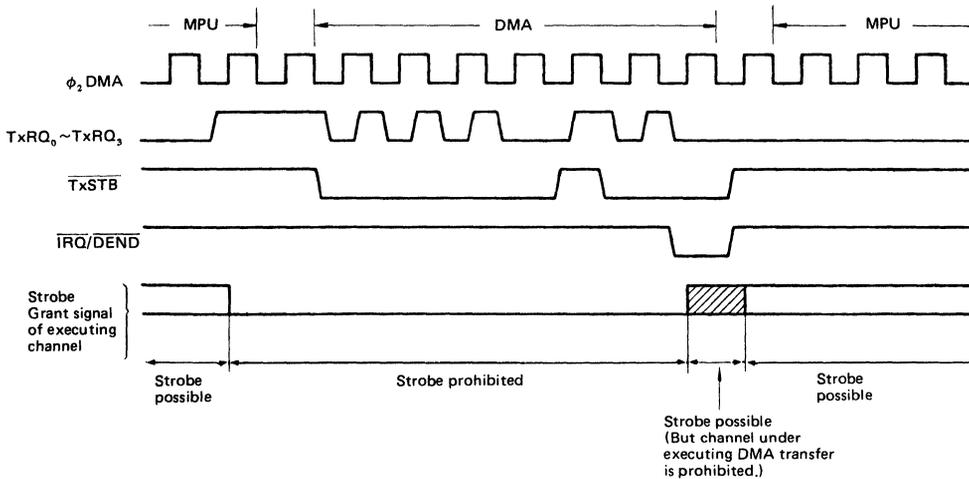


Figure 20 Strobe Timing of Executing-Channel-Number-Latch-Circuit (the burst mode)

Rotate Mode

There are two operation modes in priority-order-determining circuit. These are Normal Mode and Rotate Mode. In the normal mode, the order of priority is fixed at numerical order. (Channel 0 is given a first priority and then is followed by Channel 1 → 2 → 3.) In the rotate mode, the channel next to the channel with

which DMA was executed in the last sequence, is given a first priority and the channel in the last sequence is given a last priority. But immediately after it gets into the reset state, the order of priority is the following: Channel 0 → 1 → 2 → 3. An example of the rotate mode is shown in Fig. 21.

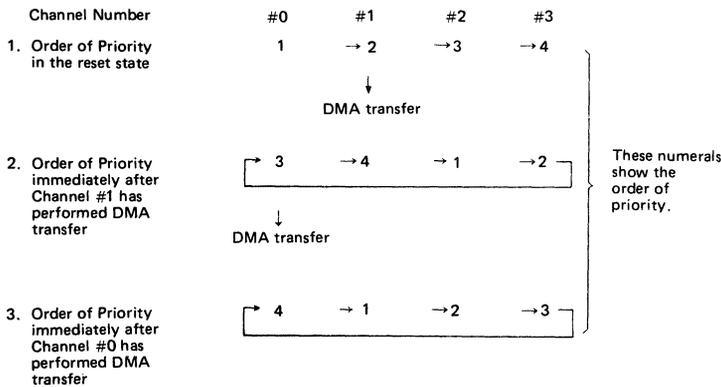


Figure 21 Example of Operation in the Rotate Mode

Next, Fig. 22 shows an example of the difference between the operation in the rotate mode and that in the normal mode. In this example, TxRQ of all channels is always at "High" level.

Moreover, BCR=2 and TxEN=1 are assumed. As a transfer mode, HALT cycle steal mode is used.

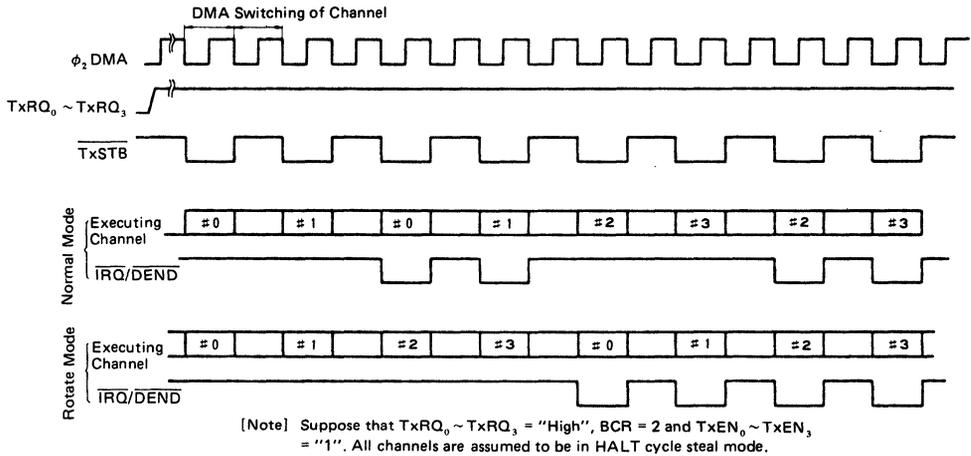


Figure 22 Difference between the operation in the rotate mode and that in the normal mode

The reason why the order of priority is not #0 → #0 → #1 → #1 → --- in the normal mode is that during DMA transfer operation, TxRQ of an executing channel is prohibited from being accepted.

DMA Operation Timing with priority control

When more than 2 channels perform DMA transfer in parallel, the abovementioned priority-order-determining-circuit is used to determine the priority. The channel with lower priority waits until the channel with higher priority completes the transfer. Then it gets into DMA transfer operation. In this case, The following combinations of transfer modes are conceivable.

- (1) From HALT mode to HALT mode (Fig. 23)
- (2) From TSC mode to TSC mode (Fig. 24)
- (3) From HALT mode to TSC mode
- (4) From TSC mode to HALT mode

In changing from HALT mode to HALT mode, only one dead cycle is intervened. That is, even in the cycle steal mode, DMA transfer of the next channel is performed without returning the bus control to the MPU (DRQH remains "Low").

In changing from TSC mode to TSC mode, DMA transfer

of the next channel is performed, after returning the bus control to MPU for one cycle.

In the case of HALT → HALT, it doesn't return the bus control to MPU in order not to increase the response time of DMA transfer and dead cycles of the system.

On the other hand, in the case of TSC → TSC mode, same mean cannot be applicable because MPU clock cannot remain stopped for a long time as in the case of HALT mode.

Both in the case of HALT → TSC mode and in the case of TSC → HALT mode, DMA operation timing is based on the same idea as the above two kinds of mode change. (In detail, see Fig. 25).

The timing in the case where the next byte is transferred without changing the channel is shown in Fig. 26. This is the case of HALT → HALT mode. In this case, the bus control returns to MPU, before the next byte is transferred. In the case of TSC → TSC mode, its timing is almost the same as than in Fig. 24, that is, after 1-byte transfer has completed, MPU executes the Instruction Cycle for one clock and then DMAC executes 1-byte transfer again.

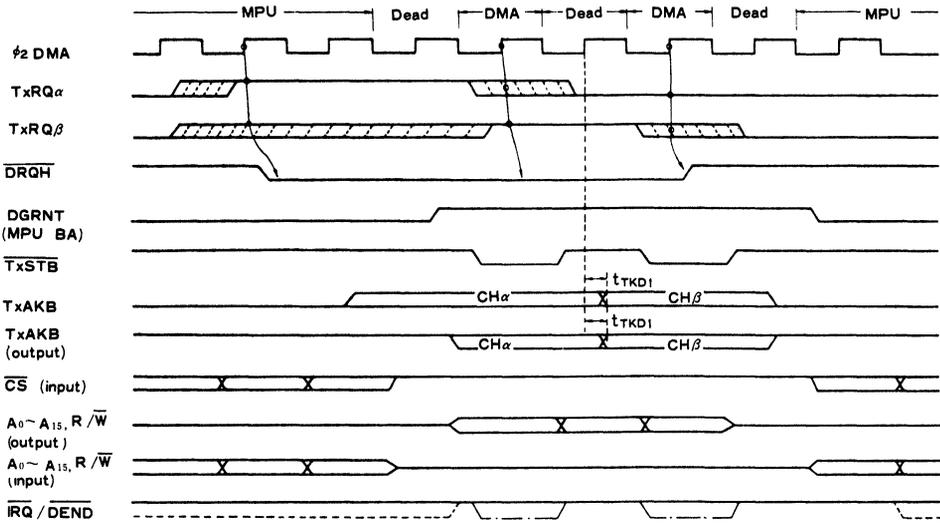


Figure 23 Channel Change (HALT Mode \rightarrow HALT Mode)

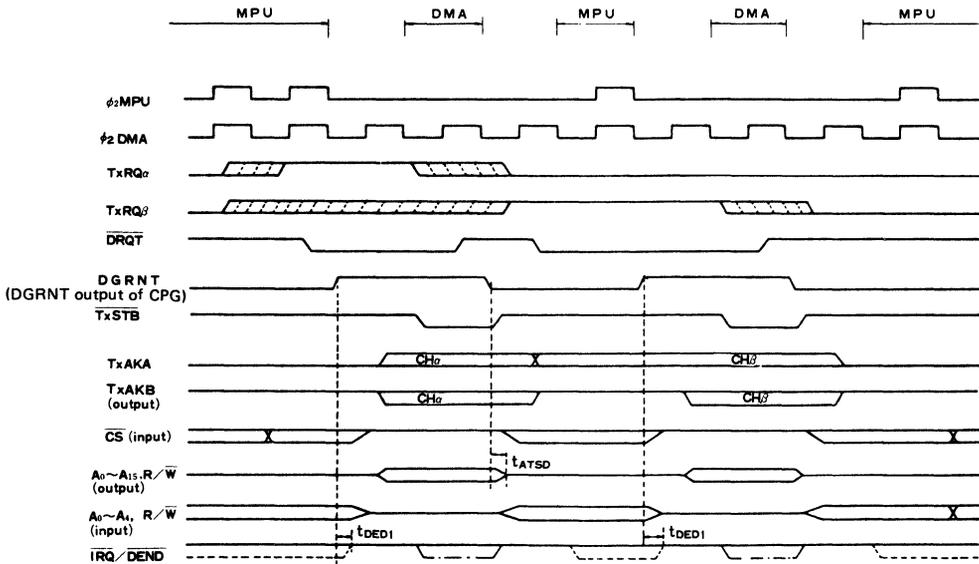


Figure 24 Channel Change (TSC Mode \rightarrow TSC Mode)

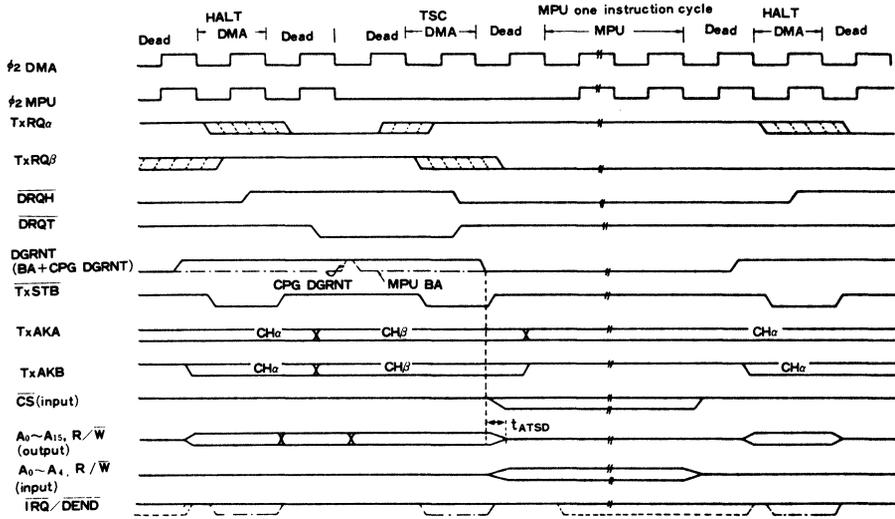
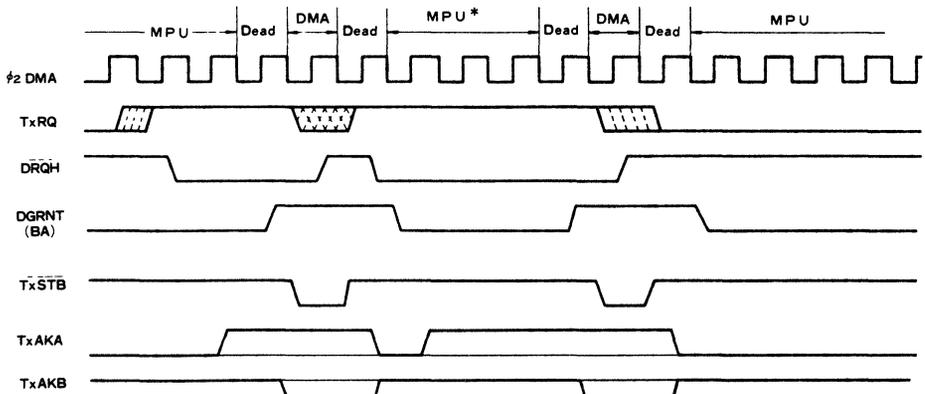


Figure 25 Channel Change (HALT Mode → TSC Mode → HALT Mode)



* Executing Period of One Instruction

Figure 26 Successive 2-byte Transfer of One Channel (HALT Cycle Steal Mode)
HALT → HALT (by one channel)

• **Status Flag**

DMAC has BUSY Flag, DEND Flag and ZERO Flag on each channel. The former two of these flags can be read out by MPU, but ZERO Flag cannot be read out. Set and reset timing of each flag are shown in Fig. 27.

BUSY/READY Flag

This flag is set to "1" when it accepts the first-byte TxRQ of its corresponding channel. After 1-block transfer has completed and BCR becomes "0", it is reset to "0". Therefore, while this flag is "1", that is, its corresponding channel is being used, the next block transfer cannot be performed.

Also this flag is cleared when corresponding TxRQ Enable Bit in the PCR becomes "0".

DEND Flag

This is the interrupt flag to indicate the end of DMA transfer of its corresponding channel. After 1-block transfer has completed and BCR becomes "0", this flag is set to "1". This flag is reset to "0" immediately after the Channel Control Register having this flag is read out.

ZERO Flag

This is the internal flag to indicate whether the data stored in the BCR is "0" or not (It cannot be read out).

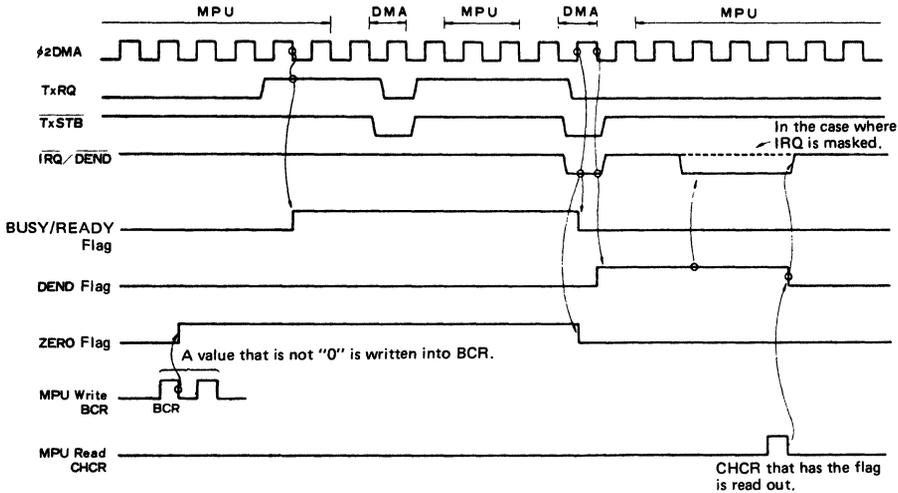


Figure 27 Timing of Status Flag (Suppose that BCR is 2 in the initial state)

When BCR is "0", ZERO Flag is "0". When BCR is not "0", it is "1".

In the reset state, this flag is "0". If data that is not "0" is written into BCR, this flag is set to "1". When BCR becomes "0" after 1-block data transfer has completed, or MPU writes "0" into BCR, this flag is reset to "0".

The function of ZERO Flag is to prohibit accepting TxRQ of its corresponding channel while this flag is "0" (that is, BCR is "0") (See Fig. 18). While ZERO Flag is "0", TxRQ is not accepted even if TxEN is "1". This function avoids a false operation even if "High" input is provided to TxRQ before the initialization of the register.

When RES pin goes to "Low", this flag becomes "0", but the number in BCR is not reset to "0". Therefore, the state of this flag and BCR are not the same. In this case new data should be written into BCR (Then ZERO Flag becomes "1").

• **DMA End Control**

Function of $\overline{\text{IRQ/DEND}}$ Pin

DMAC has $\overline{\text{IRQ}}$ output and $\overline{\text{DEND}}$ output to perform DMA End Control. These are multiplexed outputs to $\overline{\text{IRQ}}$

$\overline{\text{DEND}}$ pin.

The function of $\overline{\text{DEND}}$ output is to inform I/O controller of the end of 1-block transfer. After 1-block transfer has been completed and BCR becomes "0", $\overline{\text{DEND}}$ output provides "Low" pulse whose cycle is one clock, being synchronous with the final 1-byte data transfer. 4 channels have only one $\overline{\text{DEND}}$ output in common, so each channel determines whether $\overline{\text{DEND}}$ output is its own output or not, combining with TxAK signal. When $\overline{\text{TxAK}}$ of the channel is "Low" and $\overline{\text{DEND}}$ is "Low", it shows that the cycle is the last one of DMA (See Fig. 29 and 30).

The function of $\overline{\text{IRQ}}$ output is to inform MPU of the end of 1-block transfer by interrupting it. As shown in Fig. 28, $\overline{\text{IRQ}}$ output is logical AND-OR of the interrupt flag (DEND Flag) and IRQ Enable bit of each channel.

$\overline{\text{IRQ}}$ and $\overline{\text{DEND}}$ outputs are multiplexed. $\overline{\text{IRQ/DEND}}$ pin is used as $\overline{\text{DEND}}$ output during DMAC cycle and $\overline{\text{IRQ}}$ output during MPU cycle. Moreover, DGRNT signal separates $\overline{\text{DEND}}$ and $\overline{\text{IRQ}}$ by its "High" or "Low". In detail, see Fig. 29 and Fig. 30.

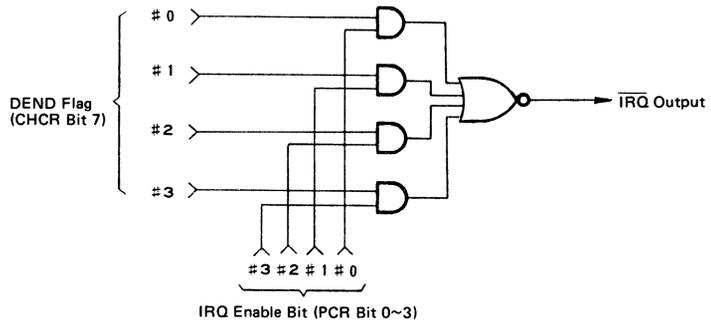


Figure 28 Logic of $\overline{\text{IRQ}}$ Output

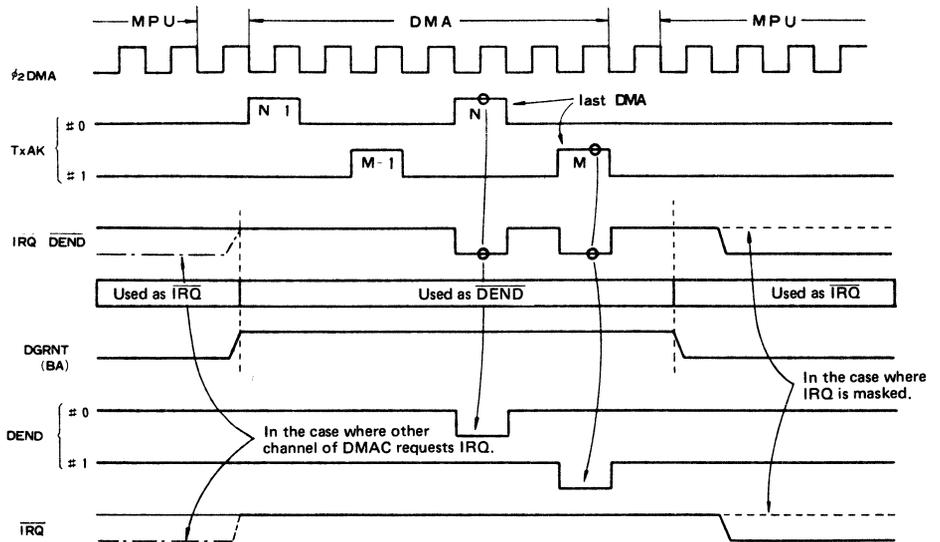


Figure 29 Timing of $\overline{\text{IRQ}}/\overline{\text{DEND}}$ Output

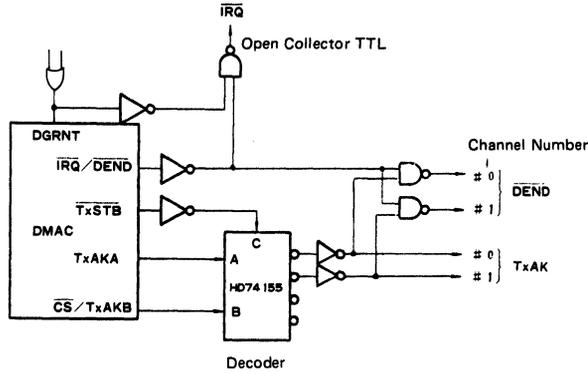


Figure 30 How to Use $\overline{\text{IRQ}}/\overline{\text{DEND}}$ Output Signal

Unusual DMA End

Following section describes how to terminate or change normal sequence of DMA transfer.

- (1) When "0" is written into BCR
When "0" is written into BCR before it becomes "0", subsequent TxRQ are not accepted and this causes the termination of the DMA transfer since the internal ZERO Flag is reset to "0". In this case, note that DEND pulse is not provided.
- (2) When "1" is written into BCR
When "1", instead of "0", is written into BCR, only the next TxRQ is accepted and 1-byte DMA transfer is performed. In this case, DEND pulse is provided, being synchronous with the last transfer.
- (3) When another value is written into ADR & BCR during the transfer
When the data in ADR & BCR are changed during the transfer, the following transfer is performed according to the change of the data.
- (4) When "0" is written into TxRQ Enable bit
When TxEN is reset to "0" during the transfer, this causes TxRQ comes not to be accepted and the transfer halts. But the state is different from that in the case (1), the number in BCR remains unchanged. Therefore, when TxEN is set to "1" again, the transfer is performed again.
- (5) When $\overline{\text{RES}}$ pin is set to "Low"
When $\overline{\text{RES}}$ is provided during the transfer, the transfer stops.
Then all of the control registers and their internal flags are reset to "0". But the data in ADR & BCR are not reset.

(Supplement)

It is only in the cycle steal mode that DMAC registers such as BCR and ADR can be read or written during the transfer. In the burst mode, it is usually impossible (But special external circuits enable it).

● **Data Chain Function**

The data chain function of DMAC is to transfer the contents of ADR & BCR of Channel #3 to ADR & BCR of a specified channel automatically and renew the data of them after the channel has completed 1-block transfer.

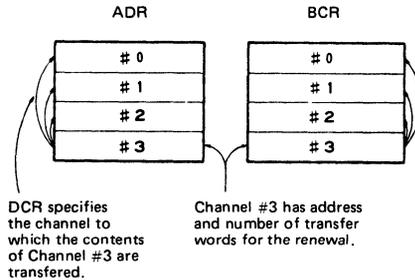


Figure 31 Data Chain Operation

Its detailed timing is shown in Fig. 32 and Fig. 33. As shown in these figures the contents of ADR & BCR of Channel #3 are transferred to the channel during the clock cycle next to the last one of 1-block transfer (which provides DEND pulse). Then $\overline{\text{DRQH}}$ or $\overline{\text{DRQT}}$ provides "Low" output for one more clock cycle than in the normal case. Therefore, MPU takes back the bus control again 1-clock later than in the normal case, that is, after the data renewal of the specified channel by the data chain from Channel #3.

In the TSC mode, the stretching period of clock ϕ_1 is longer than in the normal case.

The contents of ADR & BCR of Channel #3 remain unchanged as long as new data are not written by MPU, even if the data chain is executed.

As for $\overline{\text{DEND}}$ output, DEND Flag and BUSY Flag in the case of data chain execution, they function in the same way as in the normal case. They provide $\overline{\text{DEND}}$ pulse everytime 1-block transfer has completed, and then DEND Flag is set to "1". Therefore, in the case where more than 3-block data chain is needed, DEND Flag is used for the execution. Its sequence is shown in Fig. 34. First, DEND Flag="1" that shows the end of the first-block data chain is read out. Next, the data of ADR & BCR for the third-block data chain need to be written into Channel #3, in parallel with the execution of the second-block data chain. (This data chain is feasible only in the cycle steal mode.)

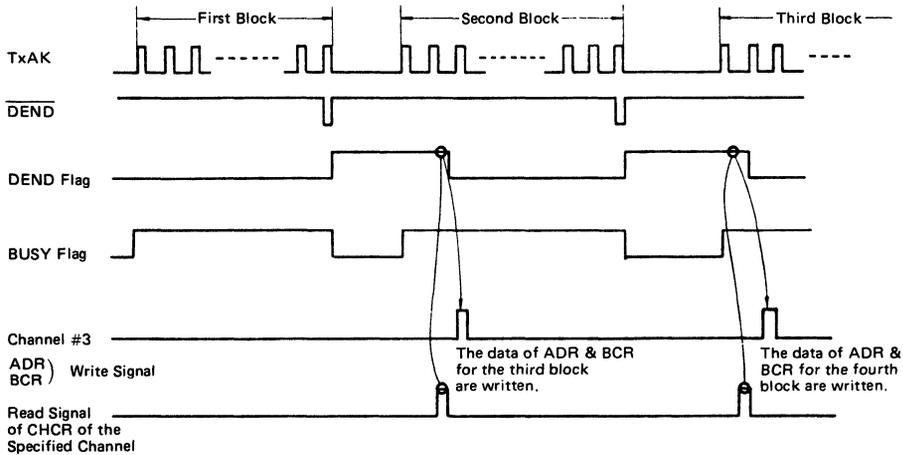


Figure 34 Sequence of More than 3-block Data Chain

■ DMAC PROGRAMMING

Preparation of a channel for a DMA transfer requires:

- 1) Load the starting address into the Address Register.
- 2) Load the number of bytes into the Byte Count Register.
- 3) Program the Channel Control Register for the transfer characteristics: direction (bit 0), mode (bits 1 and 2), and the address update (bit 3).

The channel is now configured. To enable the transfer

request, set the appropriate enable bit (bits 0~3) of the Priority Control Register, as well as the Rotate Control bit.

If an interrupt on DMA End is desired, the enable bit (bits 0~3) of the Interrupt Control Register must be set.

If data chaining for the channel is necessary, it is programmed into the Data Chain Register and the appropriate data must be written into the Address and Byte Count Registers for channel #3.

Table 8 DMAC Programming Model

Register	Address (Hex)	Register Content							
		Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Channel Control	1x*	DMA End Flag (DEND)	Busy/Ready Flag	Not Used	Not Used	Address Up/Down	TSC/Halt	Burst/Steal	Read/Write (R/W)
Priority Control	14	Rotate Control	Not Used	Not Used	Not Used	TxRQ Enable #3 (TxEN3)	TxRQ Enable #2 (TxEN2)	TxRQ Enable #1 (TxEN1)	TxRQ Enable #0 (TxEN0)
Interrupt Control	15	IRQ Flag	Not Used	Not Used	Not Used	IRQ Enable #3 (IE3)	IRQ Enable #2 (IE2)	IRQ Enable #1 (IE1)	IRQ Enable #0 (IE0)
Data Chain	16	Not Used	Not Used	Not Used	Not Used	Two/Four Channel Select (2/4)	Data Chain Channel Select B	Data Chain Channel Select A	Data Chain Enable

* The x represents the binary equivalent of the channel desired.

A comparison of the response times and maximum transfer rates is shown in Table 9. The data are shown for a system clock rate of 1 MHz.

The two 8-bit bytes that form the registers in Table 10 are placed in consecutive memory locations, making it very easy to use the MPU index register in programming them.

Fig. 38 shows an example of its minimum structure (1 channel, HALT mode, combination with FDC). Fig. 39 shows an example of its maximum structure. (but only one DMAC is used.)

Table 9 Maximum Transfer Speed & Response Time of the DMAC when $t_{cvc\phi}$ equals 1 μ sec.

Mode		Maximum Transfer Speed (μ sec/byte)	Response Time (μ sec)	
			maximum	minimum
HALT Cycle Steal		(executing time of one instruction) + 3	(executing time of one instruction) + 3.5 - t_{TQH1}	3.5 + t_{TAS1}
HALT Burst	first byte	1	2 - t_{TQH2}	1 + t_{TAS2}
	since second byte		3.5 - t_{TQH1}	2.5 + t_{TQH1}
TSC Cycle Steal		4	3.5 - t_{TQH1}	2.5 + t_{TQH1}

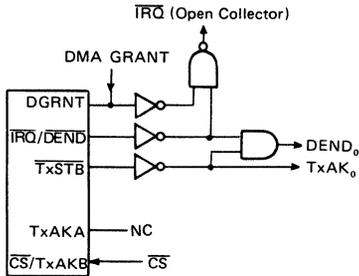


Figure 35 One Channel

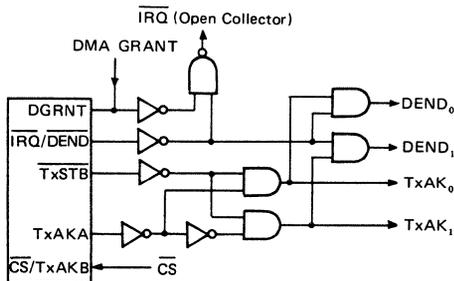


Figure 36 Two Channel

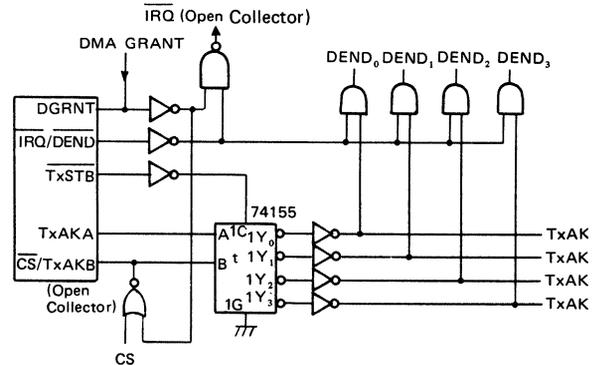


Figure 37 Four-Channel

Table 10 Address and Byte Count Registers

Register	Channel	Address (Hex)
Address High	0	0
Address Low	0	1
Byte Count High	0	2
Byte Count Low	0	3
Address High	1	4
Address Low	1	5
Byte Count High	1	6
Byte Count Low	1	7
Address High	2	8
Address Low	2	9
Byte Count High	2	A
Byte Count Low	2	B
Address High	3	C
Address Low	3	D
Byte Count High	3	E
Byte Count Low	3	F

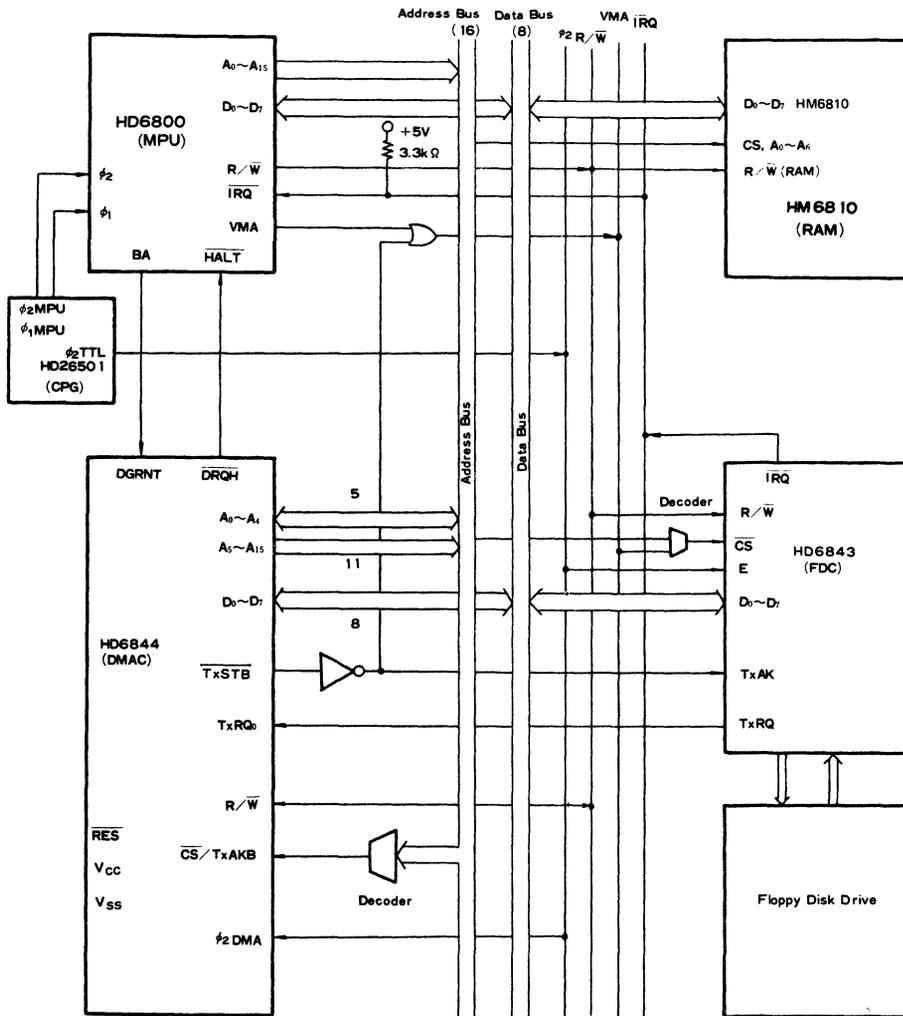


Figure 38 Example of DMA System Structure (1) (minimum)

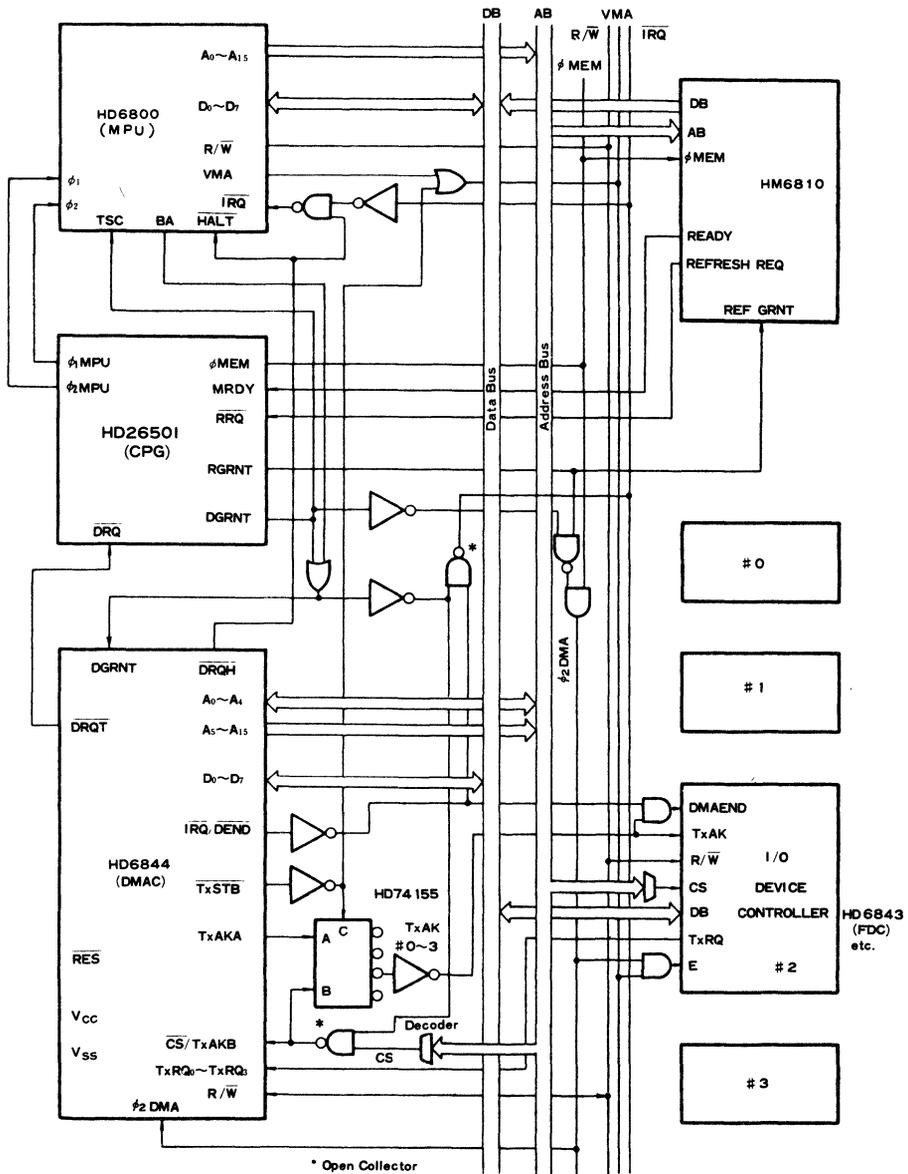
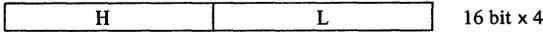


Figure 39 Example of DMA System Structure (2) (maximum)

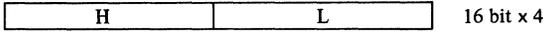
■ APPENDIX

Contents of the DMAC Registers

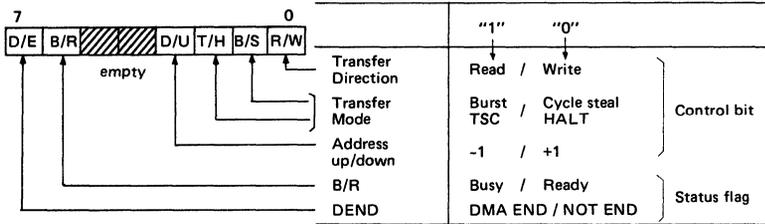
(1) ADR0 ~ ADR3 (Address Register) (1 ADR on each channel)



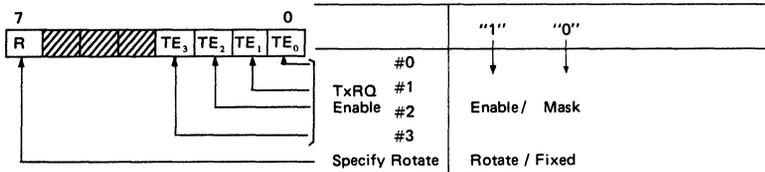
(2) BCR0 ~ BCR3 (Byte Count Register) (1 BCR on each channel)



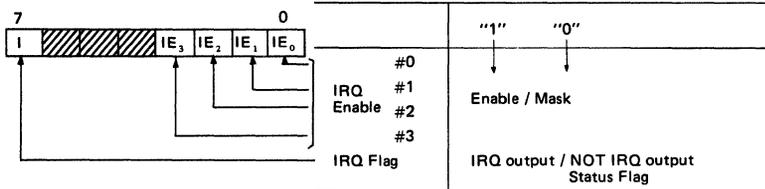
(3) CHCR0 ~ CHCR3 (Channel Control Register) (1 CHCR on each channel) (6 bit x 4)



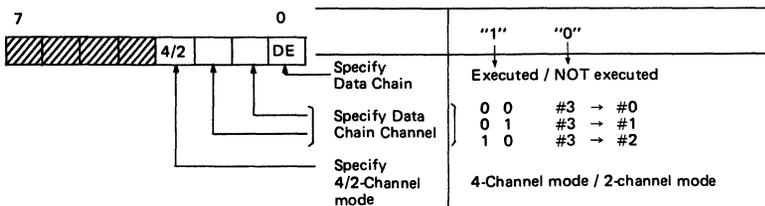
(4) PCR (Priority Control Register) (5 bit x 1)



(5) ICR (Interrupt Control Register) (5 bit x 1)



(6) DCR (Data Chain Control Register) (4 bit x 1)



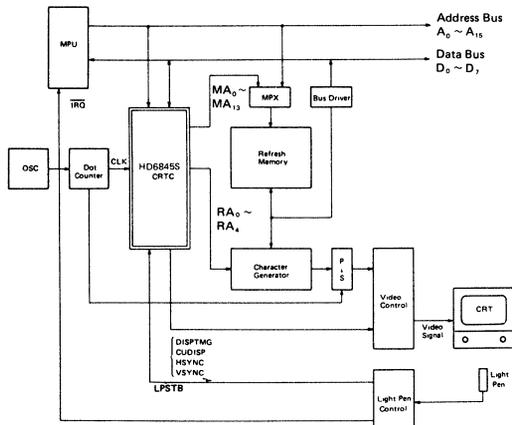
HD6845S, HD68A45S, HD68B45S CRTC (CRT Controller)

The CRTC is a LSI controller which is designed to provide an interface for microcomputers to raster scan type CRT displays. The CRTC belongs to the HMCS6800 LSI Family and has full compatibility with MPU in both data lines and control lines. Its primary function is to generate timing signal which is necessary for raster scan type CRT display according to the specification programmed by MPU. The CRTC is also designed as a programmable controller, so applicable to wide-range CRT display from small low-functioning character display up to raster type full graphic display as well as large high-functioning limited graphic display.

■ FEATURES

- Number of Displayed Characters on the Screen, Vertical Dot Format of One Character, Horizontal and Vertical Sync Signal, Display Timing Signal are Programmable
- 3.7 MHz High Speed Display Operation
- Line Buffer-less Refreshing
- 14-bit Refresh Memory Address Output (16k Words max. Access)
- Programmable Interlace/Non-interlace Scan Mode
- Built-in Cursor Control Function
- Programmable Cursor Height and its Blink
- Built-in Light Pen Detection Function
- Paging and Scrolling Capability
- TTL Compatible
- Single +5V Power Supply

■ SYSTEM BLOCK DIAGRAM



■ ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Value	Unit
Supply Voltage	V_{CC}^*	-0.3 ~ +7.0	V
Input Voltage	V_{in}^*	-0.3 ~ +7.0	V
Operating Temperature	T_{opr}	-20 ~ +75	°C
Storage Temperature	T_{stg}	-55 ~ +150	°C

* With respect to V_{SS} (SYSTEM GND)

[NOTE] Permanent LSI damage may occur if maximum ratings are exceeded. Normal operation should be under recommended operating conditions. If these conditions are exceeded, it could affect reliability of LSI.

■ RECOMMENDED OPERATING CONDITIONS

Item	Symbol	min	typ	max	Unit
Supply Voltage	V_{CC}^*	4.75	5.0	5.25	V
Input Voltage	V_{IL}^*	-0.3	-	0.8	V
	V_{IH}^*	2.0	-	V_{CC}	V
Operating Temperature	T_{opr}	-20	25	75	°C

* With respect to V_{SS} (SYSTEM GND)

■ ELECTRICAL CHARACTERISTICS

● DC CHARACTERISTICS ($V_{CC} = 5V \pm 5\%$, $V_{SS} = 0V$, $T_a = -20 \sim +75^\circ C$, unless otherwise noted.)

Item	Symbol	Test Condition	min	typ*	max	Unit	
Input "High" Voltage	V_{IH}		2.0	-	V_{CC}	V	
Input "Low" Voltage	V_{IL}		-0.3	-	0.8	V	
Input Leakage Current	I_{in}	$V_{in} = 0 \sim 5.25V$ (Except $D_0 \sim D_7$)	-2.5	-	2.5	μA	
Three-State Input Current (off-state)	I_{TSI}	$V_{in} = 0.4 \sim 2.4V$ $V_{CC} = 5.25V$ ($D_0 \sim D_7$)	-10	-	10	μA	
Output "High" Voltage	V_{OH}	$I_{LOAD} = -205 \mu A$ ($D_0 \sim D_7$)	2.4	-	-	V	
		$I_{LOAD} = -100 \mu A$ (Other Outputs)					
Output "Low" Voltage	V_{OL}	$I_{LOAD} = 1.6 mA$	-	-	0.4	V	
Input Capacitance	C_{in}	$V_{in} = 0$ $T_a = 25^\circ C$ $f = 1.0 MHz$	$D_0 \sim D_7$	-	-	12.5	pF
			Other Inputs	-	-	10.0	pF
Output Capacitance	C_{out}	$V_{in} = 0V$, $T_a = 25^\circ C$, $f = 1.0 MHz$	-	-	10.0	pF	
Power Dissipation	P_D		-	600	1000	mW	

* $T_a = 25^\circ C$, $V_{CC} = 5.0V$

• AC CHARACTERISTICS ($V_{CC} = 5V \pm 5\%$, $V_{SS} = 0V$, $T_a = -20 \sim +75^\circ C$, unless otherwise noted.)

1. TIMING OF CRT SIGNAL

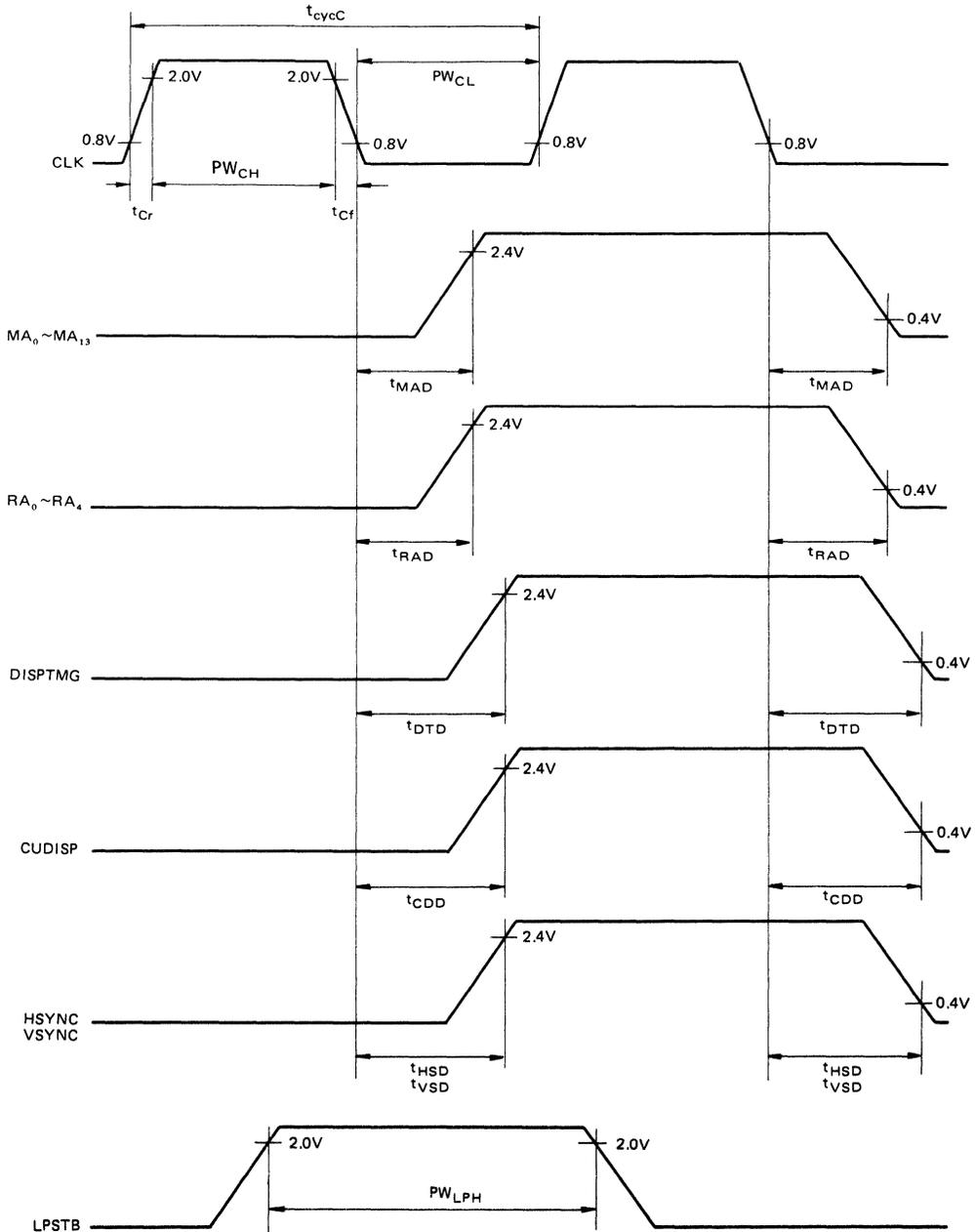
Item	Symbol	Test Condition	min	typ	max	Unit
Clock Cycle Time	t_{cycC}	Fig. 1	270	—	—	ns
Clock "High" Pulse Width	PW_{CH}		130	—	—	ns
Clock "Low" Pulse Width	PW_{CL}		130	—	—	ns
Rise and Fall Time for Clock Input	t_{Cr}, t_{Cf}		—	—	20	ns
Memory Address Delay Time	t_{MAD}		—	—	160	ns
Raster Address Delay Time	t_{RAD}		—	—	160	ns
DISPTMG Delay Time	t_{DTP}		—	—	250	ns
CUDISP Delay Time	t_{CDD}		—	—	250	ns
Horizontal Sync Delay Time	t_{HSD}		—	—	200	ns
Vertical Sync Delay Time	t_{VSD}		—	—	250	ns
Light Pen Strobe Pulse Width	PW_{LPH}		—	—	—	ns
Light Pen Strobe Uncertain Time of Acceptance	t_{LPD1}	Fig. 2	—	—	70	ns
	t_{LPD2}		—	—	0	ns

2. MPU READ TIMING

Item	Symbol	Test Condition	HD6845S			HD68A45S			HD68B45S			Unit
			min	typ	max	min	typ	max	min	typ	max	
Enable Cycle Time	t_{cycE}	Fig. 3	1.0	—	—	0.666	—	—	0.5	—	—	μs
Enable "High" Pulse Width	PW_{EH}		0.45	—	—	0.28	—	—	0.22	—	—	μs
Enable "Low" Pulse Width	PW_{EL}		0.40	—	—	0.28	—	—	0.21	—	—	μs
Errable Rise and Fall Time	t_{Er}, t_{Ef}		—	—	25	—	—	25	—	—	25	ns
Address Set Up Time	t_{AS}		140	—	—	140	—	—	70	—	—	ns
Data Delay Time	t_{DDR}		—	—	320	—	—	220	—	—	180	ns
Data Hold Time	t_H		10	—	—	10	—	—	10	—	—	ns
Address Hold Time	t_{AH}		10	—	—	10	—	—	10	—	—	ns
Data Access Time	t_{ACC}		—	—	460	—	—	360	—	—	250	ns

3. MPU WRITE TIMING

Item	Symbol	Test Condition	HD6845S			HD68A45S			HD68B45S			Unit
			min	typ	max	min	typ	max	min	typ	max	
Enable Cycle Time	t_{cycE}	Fig. 4	1.0	—	—	0.666	—	—	0.5	—	—	μs
Enable "High" Pulse Width	PW_{EH}		0.45	—	—	0.28	—	—	0.22	—	—	μs
Enable "Low" Pulse Width	PW_{EL}		0.40	—	—	0.28	—	—	0.21	—	—	μs
Enable Rise and Fall Time	t_{Er}, t_{Ef}		—	—	25	—	—	25	—	—	25	ns
Address Set Up Time	t_{AS}		140	—	—	140	—	—	70	—	—	ns
Data Set Up Time	t_{DSW}		195	—	—	80	—	—	60	—	—	ns
Data Hold Time	t_H		10	—	—	10	—	—	10	—	—	ns
Address Hold Time	t_{AH}		10	—	—	10	—	—	10	—	—	ns



This Figure shows the relation in time between CLK signal and each output signals. Output sequence is shown in Figs. 10~15.

Figure 1 Time Chart of the CRTC

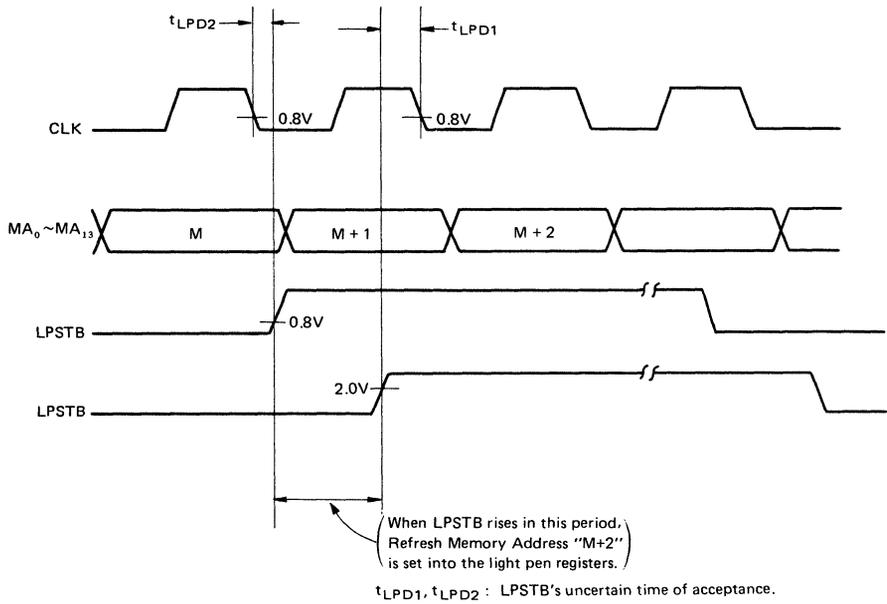


Figure 2 LPSTB Input Timing & Refresh Memory Address that is set into the light pen registers.

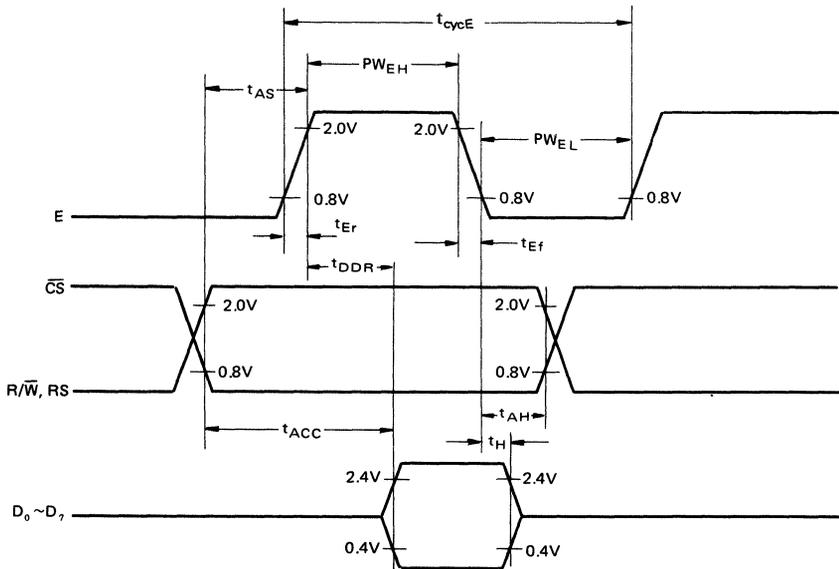


Figure 3 Read Sequence

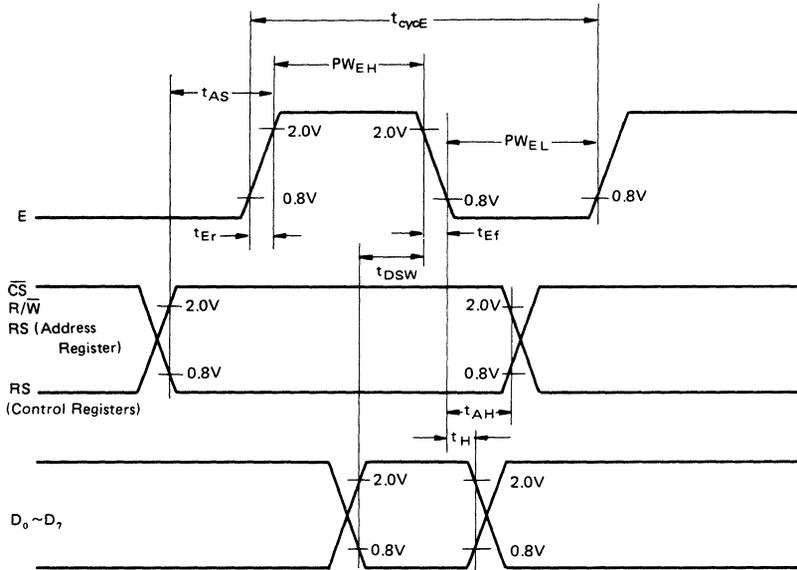


Figure 4 Write Sequence

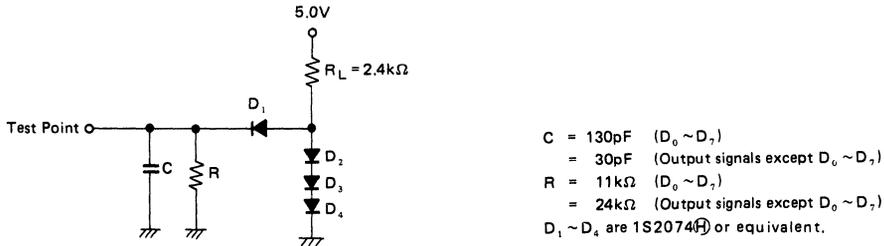


Figure 5 Test Loads

■ SYSTEM DESCRIPTION

The CRTC is a LSI which is connected with MPU and CRT display device to control CRT display. The CRTC consists of internal register group, horizontal and vertical timing circuits, linear address generator, cursor control circuit, and light pen detection circuit. Horizontal and vertical timing circuit generate $RA_0 \sim RA_4$, DISPTMG, HSYNC, and VSYNC. $RA_0 \sim RA_4$ are raster address signals and used as input signals for Character Generator. DISPTMG, HSYNC, and VSYNC signals are received by video control circuit. This horizontal and vertical timing circuit consists of internal counter and comparator circuit.

Linear address generator generates refresh memory address $MA_0 \sim MA_{13}$ to be used for refreshing the screen. By these address signals, refresh memory is accessed periodically. As 14 refresh memory address signals are prepared, 16k words max are accessible. Moreover, the use of start address register enables paging and scrolling. Light pen detection circuit detects light pen position on the screen. When light pen strobe signal is received, light pen register memorizes linear address generated by linear address generator in order to memorize where light pen is on the screen. Cursor control circuit controls the position of cursor, its height, and its blink.

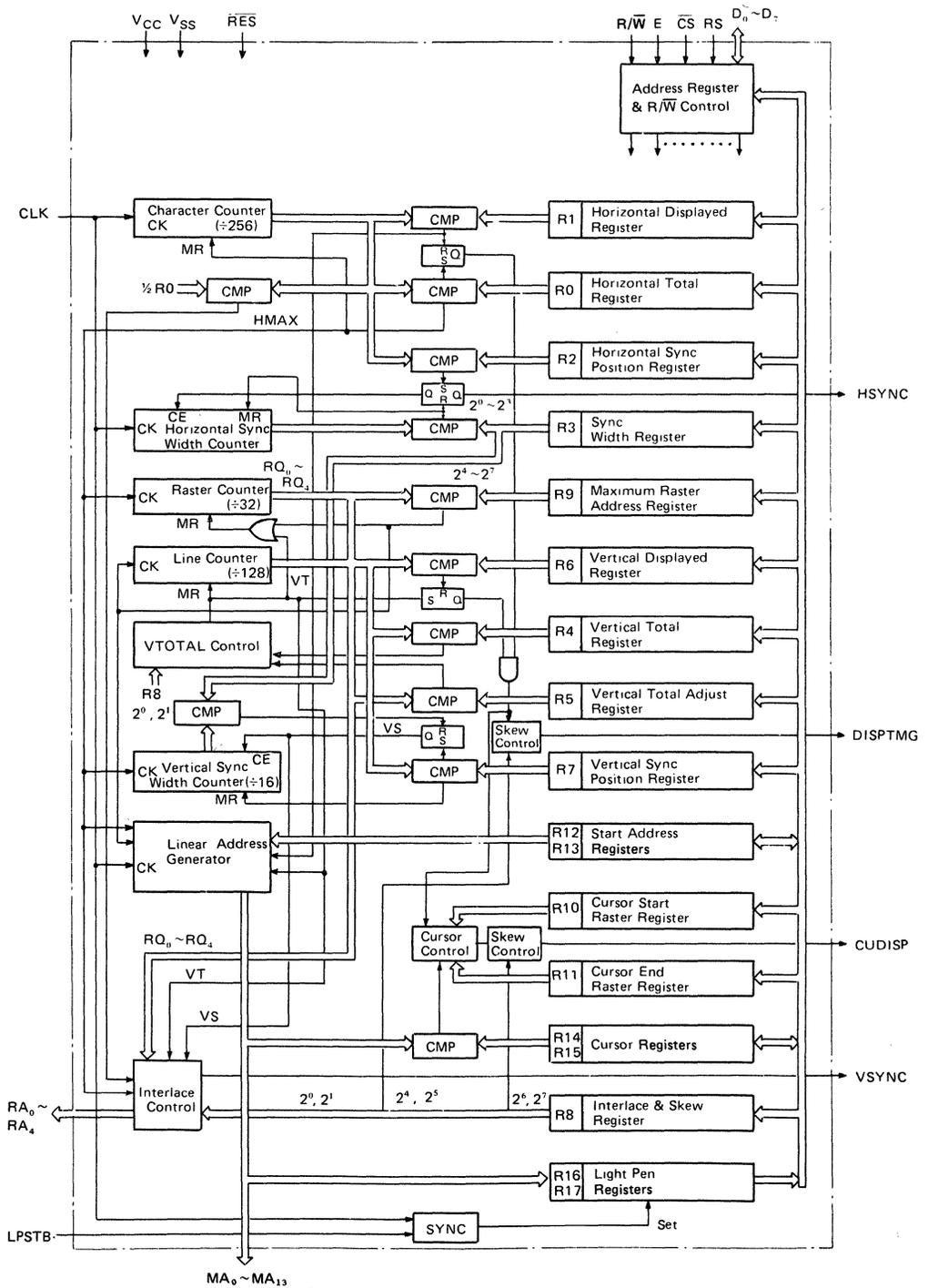


Figure 6 Internal Block Diagram of the CRTC

■ FUNCTION OF SIGNAL LINE

The CRTC provides 13 interface signals to MPU and 25 interface signals to CRT display.

● Interface Signals to MPU

Bi-directional Data Bus ($D_0 \sim D_7$)

Bi-directional data bus ($D_0 \sim D_7$) are used for data transfer between the CRTC and MPU. The data bus outputs are 3-state buffers and remain in the high-impedance state except when MPU performs a CRTC read operation.

Read/Write (R/\bar{W})

Read/Write signal (R/\bar{W}) controls the direction of data transfer between the CRTC and MPU. When R/\bar{W} is at "High" level, data of CRTC is transferred to MPU. When R/\bar{W} is at "Low" level, data of MPU is transferred to CRTC.

Chip Select (\bar{CS})

Chip Select signal (\bar{CS}) is used to address the CRTC. When \bar{CS} is at "Low" level, it enables Read/Write operation to CRTC internal registers. Normally this signal is derived from decoded address signal of MPU under the condition that VMA of MPU is at "High" level.

Register Select (RS)

Register Select signal (RS) is used to select the address register and 18 control registers of the CRTC. When RS is at "Low" level, the address register is selected and when RS is at "High" level, control registers are selected. This signal is normally a derivative of the lowest bit (A0) of MPU address bus.

Enable (E)

Enable signal (E) is used as strobe signal in MPU Read/Write operation with the CRTC internal registers. This signal is normally a derivative of the HMCS6800 System ϕ_2 clock.

Reset (\bar{RES})

Reset signal (\bar{RES}) is an input signal used to reset the CRTC. When \bar{RES} is at "Low" level, it forces the CRTC into the following status.

- 1) All the counters in the CRTC are cleared and the device stops the display operation.
- 2) All the outputs go down to "Low" level.
- 3) Control registers in the CRTC are not affected and remain unchanged.

This signal is different from other HMCS6800 family LSIs in the following functions and has restrictions for usage.

- 1) \bar{RES} has capability of reset function only when LPSTB is at "Low" level.
- 2) The CRTC starts the display operation immediately after \bar{RES} goes "High" level.

● Interface Signals to CRT Display Device

Character Clock (CLK)

CLK is a standard clock input signal which defines character timing for the CRTC display operation. CLK is normally derived from the external high-speed dot timing logic.

Horizontal Sync (HSYNC)

HSYNC is an active "High" level signal which provides horizontal synchronization for display device.

Vertical Sync (VSYNC)

VSYNC is an active "High" level signal which provides vertical synchronization for display device.

Display Timing (DISPTMG)

DISPTMG is an active "High" level signal which defines the display period in horizontal and vertical raster scanning. It is necessary to enable video signal only when DISPTMG is at "High" level.

Refresh Memory Address ($MA_0 \sim MA_{13}$)

$MA_0 \sim MA_{13}$ are refresh memory address signals which are used to access to refresh memory in order to refresh the CRT screen periodically. These outputs enables 16k words max. refresh memory access. So, for instance, these are applicable up to 2000 characters/screen and 8-page system.

Raster Address ($RA_0 \sim RA_4$)

$RA_0 \sim RA_4$ are raster address signals which are used to select the raster of the character generator or graphic pattern generator etc.

Cursor Display (CUDISP)

CUDISP is an active "High" level video signal which is used to display the cursor on the CRT screen. This output is inhibited while DISPTMG is at "Low" level. Normally this output is mixed with video signal and provided to the CRT display device.

Light Pen Strobe (LPSTB)

LPSTB is an active "High" level input signal which accepts strobe pulse detected by the light pen and control circuit. When this signal is activated, the refresh memory address ($MA_0 \sim MA_{13}$) which are shown in Fig. 2 are stored in the 14-bit light pen register. The stored refresh memory address need to be corrected in software, taking the delay time of the display device, light pen, and light pen control circuits into account.

■ FUNCTION OF INTERNAL REGISTERS

● **Address Register (AR)**

This is a 5-bit register used to select 18 internal control registers (R0~R17). Its contents are the address of one of 18 internal control registers. Programming the data from 18 to 31 produces no results. Access to R0~R17 requires, first of all, to write the address of corresponding control register into this register. When RS and CS are at "Low" level, this register is selected.

● **Horizontal Total Register (R0)**

This is a register used to program total number of horizontal characters per line including the retrace period. The data is 8-bit and its value should be programmed according to the specification of the CRT. When M is total number of characters, M-1 shall be programmed to this register. When programming for interlace mode, M must be even.

● **Horizontal Displayed Register (R1)**

This is a register used to program the number of horizontal displayed characters per line. Data is 8-bit and any number that is smaller than that of horizontal total characters can be programmed.

● **Horizontal Sync Position Register (R2)**

This is a register used to program horizontal sync position as multiples of the character clock period. Data is 8-bit and any number that is lower than the horizontal total number can be programmed. When H is character number of horizontal Sync Position, H-1 shall be programmed to this register. When programmed value of this register is increased, the display position on the CRT screen is shifted to the left. When programmed value is decreased, the position is shifted to the right. Therefore, the optimum horizontal position can be determined by this value.

● **Sync Width Register (R3)**

This is a register used to program the horizontal sync pulse width and the vertical sync pulse width. The horizontal sync pulse width is programmed in the lower 4-bit as multiples of the character clock period. "0" can't be programmed. The vertical sync pulse width is programmed in higher 4-bit as multiples of the raster period. When "0" is programmed in higher 4-bit, 16 raster period (16H) is specified.

● **Vertical Total Register (R4)**

This is a register used to program total number of lines per frame including vertical retrace period. The data is within 7-bit and its value should be programmed according to the specification of the CRT. When N is total number of lines, N-1 shall be programmed to this register.

● **Vertical Total Adjust Register (R5)**

This is a register used to program the optimum number to adjust total number of rasters per field. This register enables to decide the number of vertical deflection frequency more strictly.

● **Vertical Displayed Register (R6)**

This is a register used to program the number of displayed character rows on the CRT screen. Data is 7-bit and any number that is smaller than that of vertical total characters can be programmed.

Table 2 Pulse Width of Vertical Sync Signal

VSW				Pulse Width
2 ⁷	2 ⁶	2 ⁵	2 ⁴	
0	0	0	0	16H
0	0	0	1	1
0	0	1	0	2
0	0	1	1	3
0	1	0	0	4
0	1	0	1	5
0	1	1	0	6
0	1	1	1	7
1	0	0	0	8
1	0	0	1	9
1	0	1	0	10
1	0	1	1	11
1	1	0	0	12
1	1	0	1	13
1	1	1	0	14
1	1	1	1	15

H; Raster period

Table 3 Pulse Width of Horizontal Sync Signal

HSW				Pulse Width
2 ³	2 ²	2 ¹	2 ⁰	
0	0	0	0	— (Note)
0	0	0	1	1 CH
0	0	1	0	2
0	0	1	1	3
0	1	0	0	4
0	1	0	1	5
0	1	1	0	6
0	1	1	1	7
1	0	0	0	8
1	0	0	1	9
1	0	1	0	10
1	0	1	1	11
1	1	0	0	12
1	1	0	1	13
1	1	1	0	14
1	1	1	1	15

CH; Character clock period
(Note) HSW = "0" can't be used.

● **Vertical Sync Position Register (R7)**

This is a register used to program the vertical sync position on the screen as multiples of the horizontal character line period. Data is 7-bit and any number that is equal to or less than vertical total characters can be programmed. When V is character number of vertical sync position, V-1 shall be programmed to this register. When programmed value of this register is increased, the display position is shifted up. When programmed value is decreased, the position is shifted down. Therefore, the optimum vertical position may be determined by this value.

● **Interlace and Skew Register (R8)**

This is a register used to program raster scan mode and skew (delay) of CUDISP and DISPTMG.

Raster Scan Mode Program Bit (V, S)

Raster scan mode is programmed in the V, S bit.

Table 4 Raster Scan Mode (2¹, 2⁰)

V	S	Raster Scan Mode
0	0	} Non-interlace Mode
1	0	
0	1	Interlace Sync Mode
1	1	Interlace Sync & Video Mode

In the non-interlace mode, the rasters of even number field and odd number field are scanned duplicatedly. In the interlace sync mode, the rasters of odd number field are scanned in the middle of even number field. Then it is controlled to display the same character pattern in two fields. In the interlace sync & video mode, the raster scan method is the same as the interlace sync mode, but it is controlled to display different character pattern in two field.

Skew Program Bit (C1, C0, D1, D0)

These are used to program the skew (delay) of CUDISP and DISPTMG.

Skew of these two kinds of signals are programmed separately.

Table 5 DISPTMG Skew Bit (2⁵, 2⁴)

D1	D0	DISPTMG
0	0	Non-skew
0	1	One-character skew
1	0	Two-character skew
1	1	Non-output

Table 6 CUDISP Skew Bit (2⁷, 2⁶)

C1	C0	CUDISP
0	0	Non-skew
0	1	One-character skew
1	0	Two-character skew
1	1	Non-output

Skew function is used to delay the output timing of CUDISP and DISPTMG in LSI for the time to access refresh memory, character generator or pattern generator, and to make the same phase with serial video signal.

● **Maximum Raster Address Register (R9)**

This is a register used to program maximum raster address within 5-bit. This register defines total number of rasters per character including line space. This register is programmed as follows.

Non-interlace Mode, Interlace Sync Mode

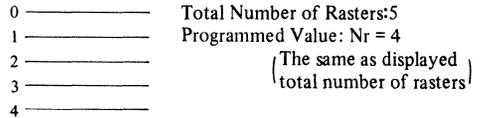
When total number of rasters is RN, RN-1 shall be programmed.

Interlace Sync & Video Mode

When total number of rasters is RN, RN-2 shall be programmed.

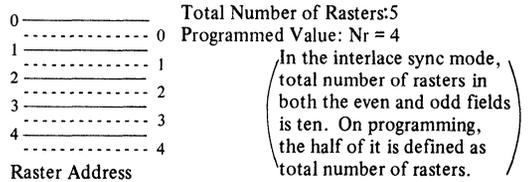
This manual defines total number of rasters in non-interlace mode, interlace sync mode and interlace sync & video mode as follows:

Non-interlace Mode



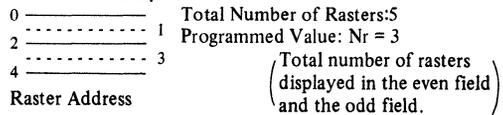
Raster Address

Interlace Sync Mode



Raster Address

Interlace Sync & Video Mode



Raster Address

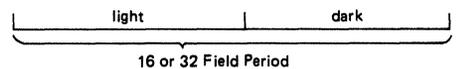
● **Cursor Start Raster Register (R10)**

This is a register used to program the cursor start raster address by lower 5-bit (2⁰~2⁴) and the cursor display mode by higher 2-bit (2⁵, 2⁶).

Table 7 Cursor Display Mode (2⁶, 2⁵)

B	P	Cursor Display Mode
0	0	Non-blink
0	1	Cursor Non-display
1	0	Blink 16 Field Period
1	1	Blink 32 Field Period

Blink Period



- **Cursor End Raster Register (R11)**
This is register used to program the cursor end raster address.
- **Start Address Register (R12, R13)**
These are used to program the first address of refresh memory to read out.
Paging and scrolling is easily performed using this register. This register can be read but the higher 2-bit ($2^6, 2^7$) of R12 are always "0".
- **Cursor Register (R14, R15)**
These two read/write registers stores the cursor location. The higher 2-bit ($2^6, 2^7$) of R14 are always "0".
- **Light Pen Register (R16, R17)**
These read only registers are used to catch the detection address of the light pen. The higher 2-bit ($2^6, 2^7$) of R16 are always "0". Its value needs to be corrected by software because there is time delay from address output of the CRTC to signal input LPSTB pin of the CRTC in the process that raster is lit after address output and light pen detects it. Moreover, delay time shown in Fig. 2 needs to be taken into account.

Restriction on Programming Internal Register

- 1) $0 < Nhd < Nht + 1 \leq 256$
- 2) $0 < Nvd < Nvt + 1 \leq 128$
- 3) $0 \leq Nhsp \leq Nht$
- 4) $0 \leq Nvsp \leq Nvt^*$
- 5) $0 \leq Ncstart \leq Ncend \leq Nr$ (Non-interlace, Interlace sync mode)
 $0 \leq Ncstart \leq Ncend \leq Nr + 1$ (Interlace sync & video mode)

- 6) $2 \leq Nr \leq 30$ (Interlace Sync & Video mode)
 - 7) $3 \leq Nht$ (Except non-interlace mode)
 $5 \leq Nht$ (Non-interlace mode only)
- * In the interlace mode, pulse width is changed $\pm 1/2$ raster time when vertical sync signal extends over two fields.

Notes for Use

The method of directly using the value programmed in the internal registers of LSI for controlling the CRT is adopted. Consequently, the display may flicker on the screen when the contents of the registers are changed from bus side asynchronously with the display operation.

Cursor Register

Writing into this register at frequent intervals for moving the cursor should be performed during horizontal and vertical retrace period.

Start Address Register

Writing into the start address register at frequent intervals for scrolling and paging should be performed during horizontal and vertical display period.

It is desirable to avoid programming other registers during display operation.

■ **OPERATION OF THE CRTC**

● **Time Chart of CRT Interface Signals**

The following example shows the display operation in which values of Table 8 are programmed to the CRTC internal registers. Fig. 7 shows the CRT screen format. Fig. 10 shows the time chart of signals output from the CRTC.

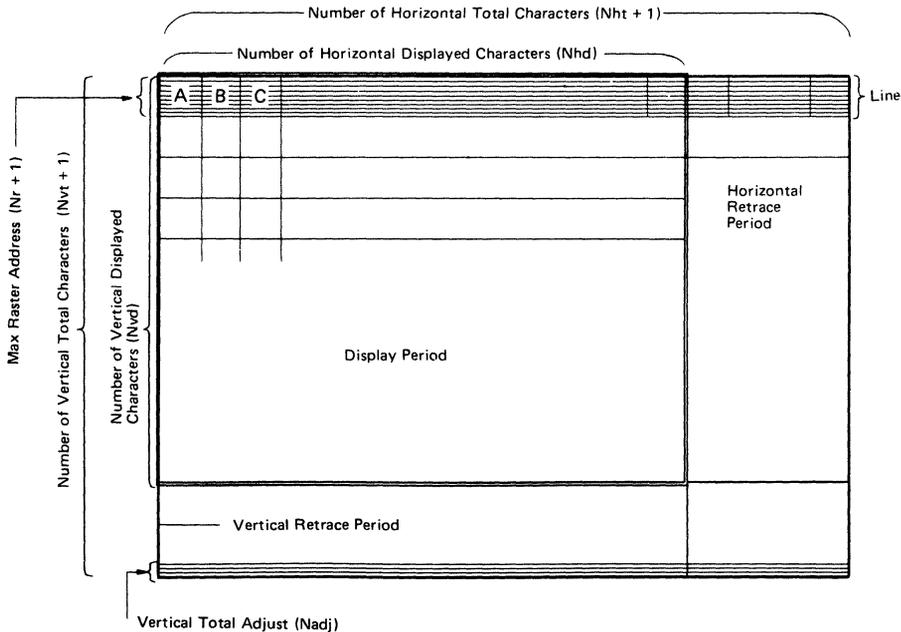


Figure 7 CRT Screen Format

Table 8 Programmed Values into the Registers

Register	Register Name	Value	Register	Register Name	Value
R0	Horizontal Total	Nht	R9	Max Raster Address	Nr
R1	Horizontal Displayed	Nhd	R10	Cursor Start Raster	
R2	Horizontal Sync Position	Nhsp	R11	Cursor End Raster	
R3	Sync Width	Nvsw, Nhsw	R12	Start Address (H)	0
R4	Vertical Total	Nvt	R13	Start Address (L)	0
R5	Vertical Total Adjust	Nadj	R14	Cursor (H)	
R6	Vertical Displayed	Nvd	R15	Cursor (L)	
R7	Vertical Sync Position	Nvsp	R16	Light Pen (H)	
R8	Interlace & Skew		R17	Light Pen (L)	

[NOTE] Nhd<Nht, Nvd<Nvt

The relation between values of Refresh Memory Address (MA₀~MA₁₃) and Raster Address (RA₀~RA₄) and the display position on the screen is shown in Fig. 16. Fig. 16 shows the case where the value of Start Address is 0.

● Interlace Control

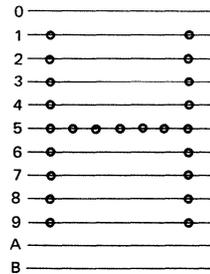
Fig. 8 shows an example where the same character is displayed in the non-interlace mode, interlace sync mode, and interlace sync & video mode.

Non-interlace Mode Control

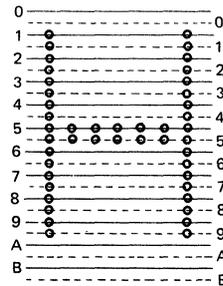
In non-interlace mode, each field is scanned duplicatedly. The values of raster addresses (RA₀~RA₄) are counted up one from 0.

Interlace Sync Mode Control

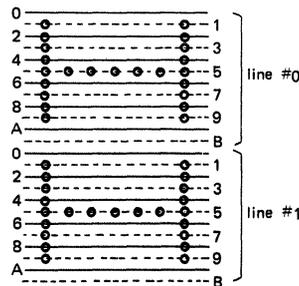
In the interlace sync mode, raster addressed in the even field and the odd field are the same as addressed in the non-interlace mode. One character pattern is displayed mutually and its displayed position in the odd field is set at 1/2 raster space down from that in the even field.



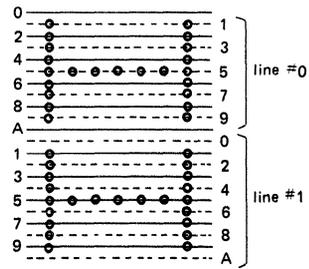
Non-interlace Mode



Interlace Sync Mode



Interlace Sync & Video Mode
(Total number of rasters in a line is even.)



Interlace Sync & Video Mode
(Total number of rasters in a line is odd.)

Figure 8 Example of Raster Scan Display

Interlace Sync & Video Mode Control

In interlace sync & video mode, the output raster address when the number of rasters is even is different from that when the number of rasters is odd.

Table 9 The Output of Raster Address in Interlace Sync & Video Mode

Total Number of Rasters in a Line	Field	Even Field	Odd Field
	Even	Even Address	Odd Address
Odd	Even Line*	Even Address	Odd Address
	Odd Line*	Odd Address	Even Address

* Internal line address begins from 0.

1) Total number of rasters in a line is even;

When number of rasters is programmed to be even, even raster address is output in the even field and odd raster address is output in the odd field.

2) Total number of rasters in a line is odd;

When total number of rasters is programmed to be odd, odd and even addresses are reversed according to the odd and even lines in each field. In this case, the difference in numbers of dots displayed between even field and odd field is usually smaller than the case of 1). Then interlace can be displayed more stably.

[NOTE] The wide disparity of dots between number of dots between even field and odd field influences beam current of CRT. CRT, which has a stable high-voltage part, can make interlace display normal. On the contrary, CRT, which has unstable high-voltage part, moves deflection angle of beam current and also dots displayed in the even and odd fields may be shifted. Characters appears distorting on a border of the screen. So 2) programming has an effect to decrease such evil influences as mentioned above. Fig. 13 shows fine chart in each mode when interlace is performed.

● **Cursor Control**

Fig. 9 shows the display patterns where each value is programmed to the cursor start raster register and the cursor end raster register. Programmed values to the cursor start raster register and the cursor end raster register need to be under the following condition.

$$\text{Cursor Start Raster Register} \leq \text{Cursor End Raster Register} \leq \text{Maximum Raster Address Register.}$$

Time chart of CUDISP is shown in Fig. 14 and Fig. 15.

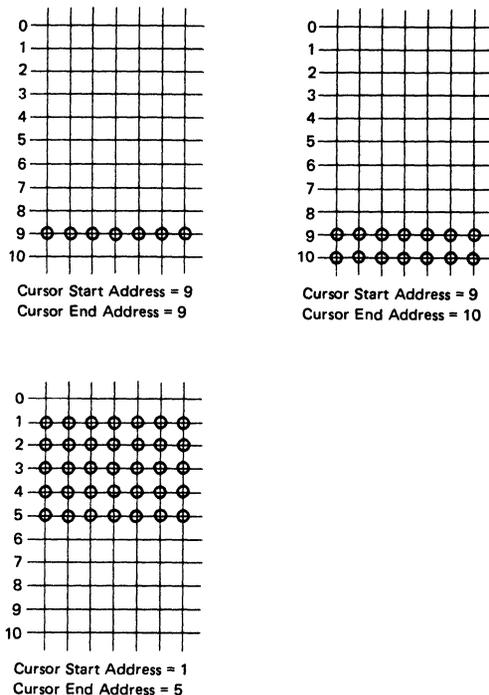


Figure 9 Cursor Control

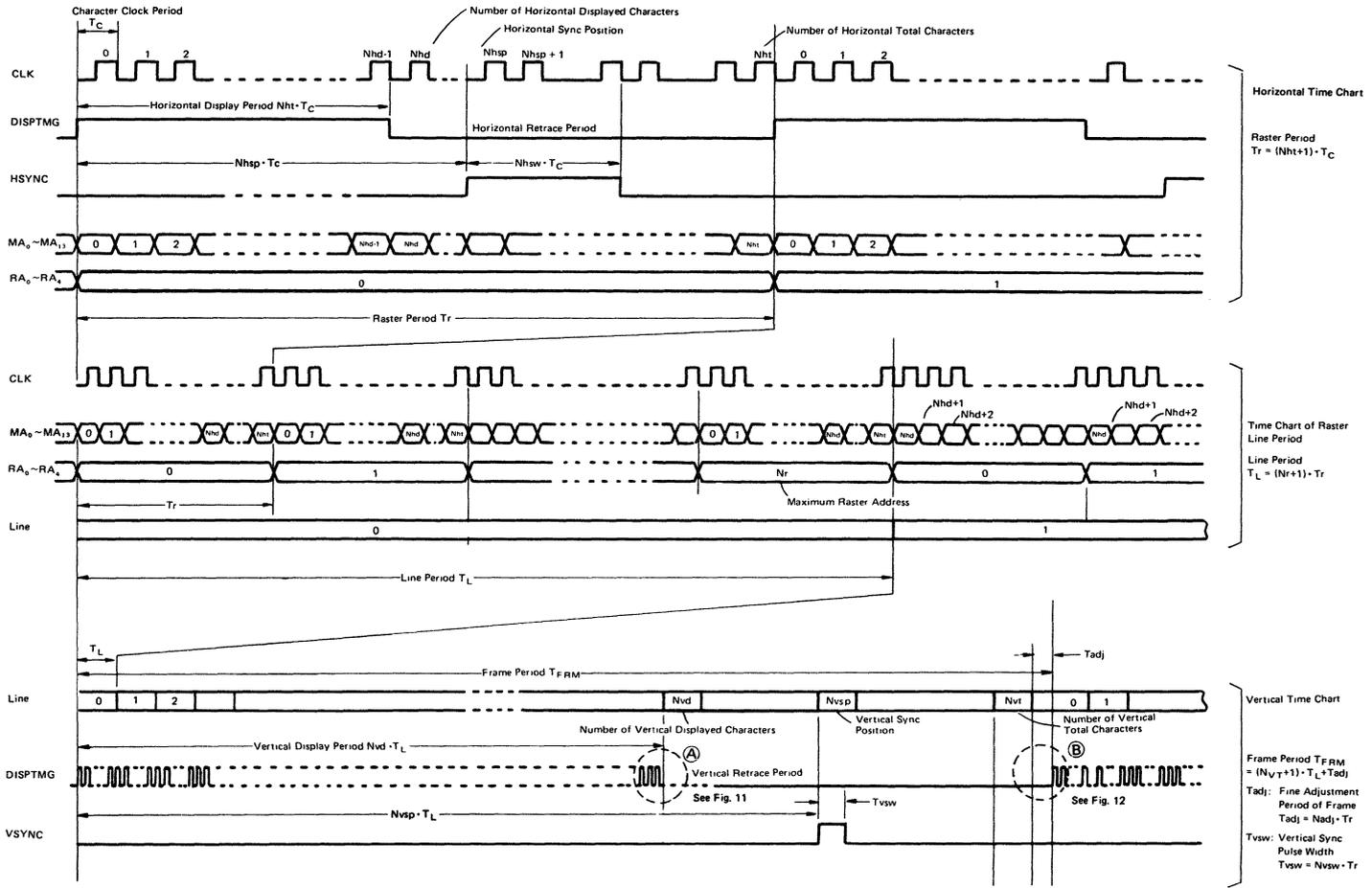


Figure 10 CRTC Time Chart
 (Output waveform of horizontal & vertical display
 in the case where values shown in Table 8 are
 Programmed to each register.)

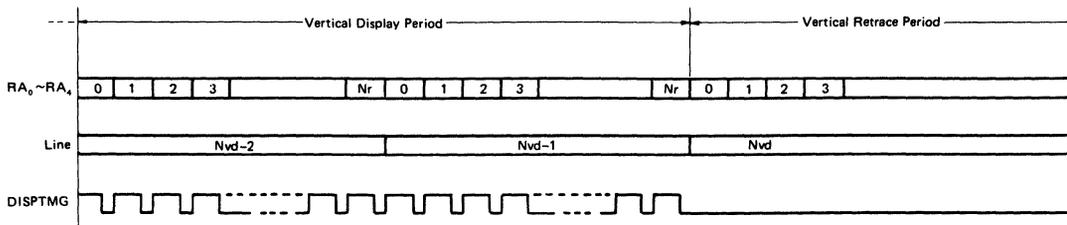


Figure 11 Switching from Vertical Display Period over to Vertical Retrace Period (Expansion of Fig. 10- Ⓐ)

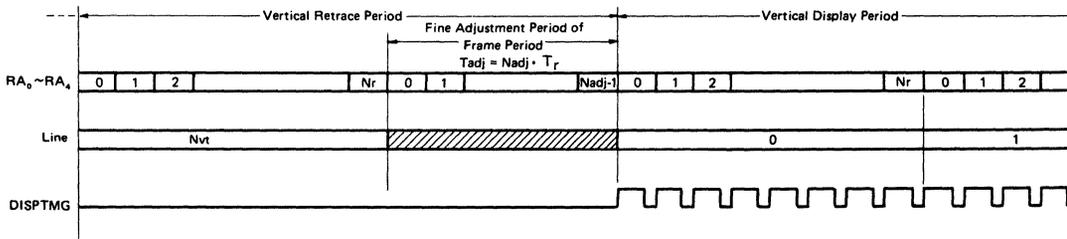


Figure 12 Fine Adjustment Period of Frame in Vertical Display
(Expansion of Fig. 10- Ⓑ)

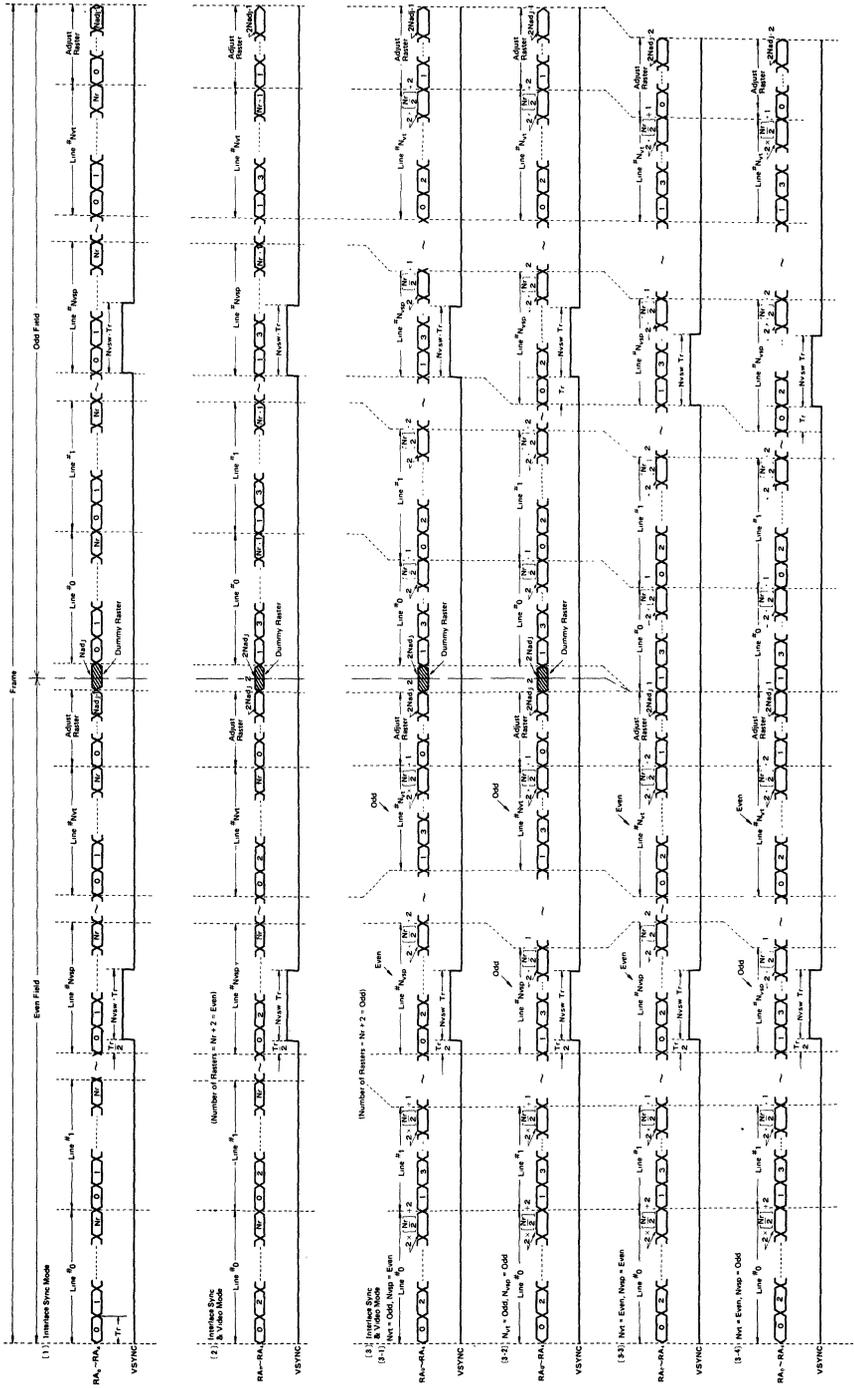


Figure 13 Interface Control

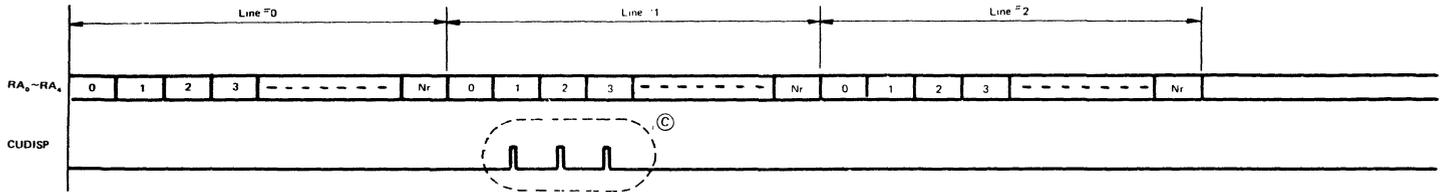
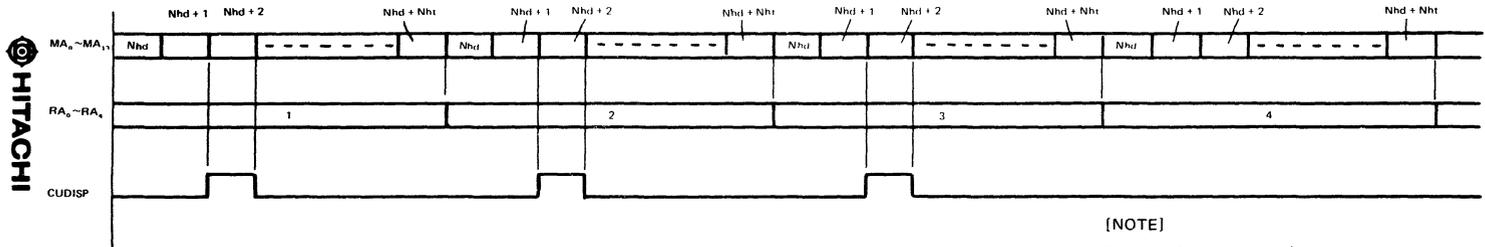


Figure 14 Relation between Line · Raster and CUDISP



[NOTE]
 (Cursor register = $Nhd+2$
 Cursor Start
 Raster Register = 1
 Cursor End
 Raster Register = 3)
 are Programmed in cursor display mode.

In blink mode, it is changed into display or non-display mode when field period is 16 or 32-time period.

Figure 15 CUDISP Timing (Expansion of Fig. 14. ©)

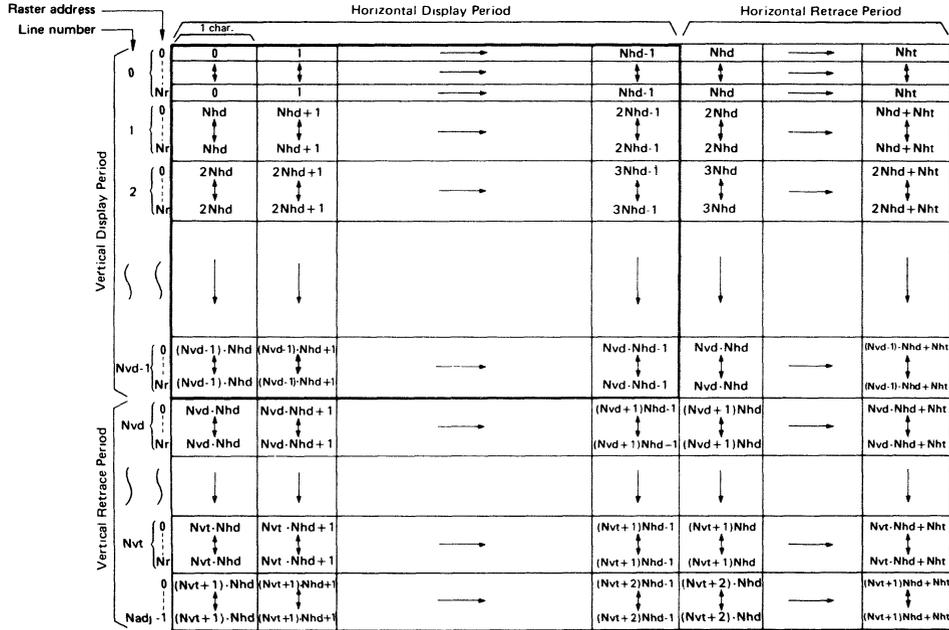


Figure 16 Refresh Memory Address ($MA_0 \sim MA_{13}$)

■ How to Use the CRTC

● Interface to MPU

As shown in Fig. 17, the CRTC is connected with the standard bus of MPU to control the data transfer between them. The CRTC address is determined by \overline{CS} and RS, and the Read/Write operation is controlled by R/ \overline{W} and E. When \overline{CS} is "Low" and RS is also "Low", the CRTC address register is selected. When \overline{CS} is "Low" and RS is "High", one of 18 internal regis-

ters is selected.

\overline{RES} is the system reset signal. When \overline{RES} becomes "Low", the CRTC internal control logic is reset. But internal registers shown in Table 1 (R0~R17) are not affected by \overline{RES} and remain unchanged.

The CRTC is designed so as to provide an interface to micro-computers, but adding some external circuits enables an interface to other data sources.

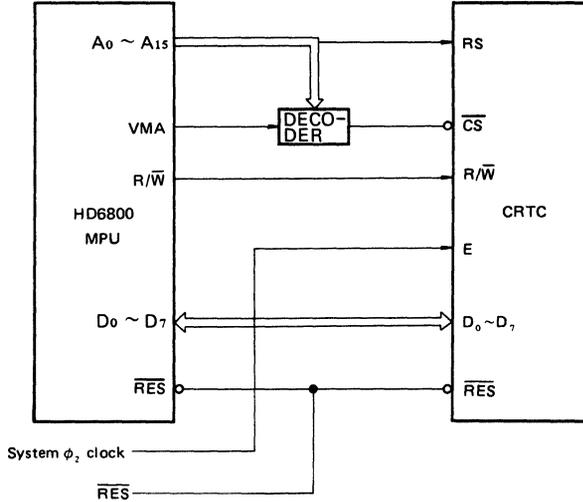


Figure 17 Interface to MPU

● Dot Timing Generating Circuit

CRTC's CLK input (21 pin) is provided with CLK which defines horizontal character time period from the outside. This CLK is generated by dot counter shown in Fig. 18. Fig. 18 shows an example of circuit where horizontal dot number of the character is "9". Fig. 19 shows the operation time chart

of dot counter shown in Fig. 18. As this example shows explicitly, CLK is at "Low" level in the former half of horizontal character time and at "High" level in the latter half. It is necessary to be careful so as not to mistake this polarity.

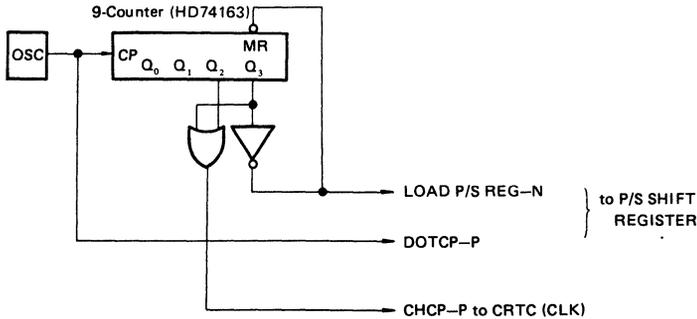


Figure 18 Example of Dot Counter

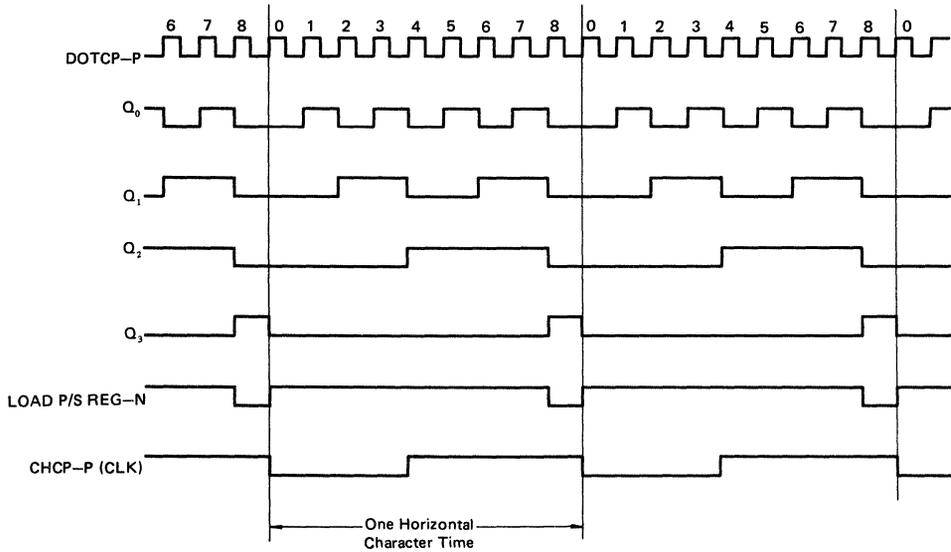


Figure 19 Time Chart of Dot Counter

■ INTERFACE TO DISPLAY CONTROL UNIT

Fig. 20 shows the interface between the CRTC and display control unit. Display control unit is mainly composed of Refresh Memory, Character Generator, and Video Control circuit. For refresh memory, 14 Memory Address line (0~16383) max are provided and for character generator, 5 Raster Address line (0~31) max are provided. For video control circuit, DISPTMG, CUDISP, HSYNC, and VSYNC are sent out. DISPTMG is used to control the blank period of video signal. CUDISP is used as video signal to display the cursor on the CRT screen. Moreover, HSYNC and VSYNC are used as drive signals respectively for CRT horizontal and vertical deflection circuits.

Outputs from video control circuit, (video signals and sync signals) are provided to CRT display unit to control the deflection and brightness of CRT, thus characters are displayed on the screen.

Fig. 21 shows detailed block diagram of display control unit. This shows how to use CUDISP and DISPTMG. CUDISP and DISPTMG should be used being latched at least one time at external flip-flop F1 and F2. Flip-flop F1 and F2 function to make one-character delay time so as to synchronize them with video signal from parallel-serial converter. High-speed D type flip-flop as TTL is used for this purpose. After being delayed at F1 and F2 DISPTMG is AND-ed with character video signal, and CUDISP is Or-ed with output from AND gate. By using this circuitry, blanking of horizontal and vertical retrace time is controlled. And cursor video is mixed with character video signal.

Fig. 21 shows the example in the case that both refresh memory and Character Generator can be accessed for horizontal one character time. Time chart for this case is shown in Fig. 24. This method is used when a few character needed to be displayed in horizontal direction on the screen.

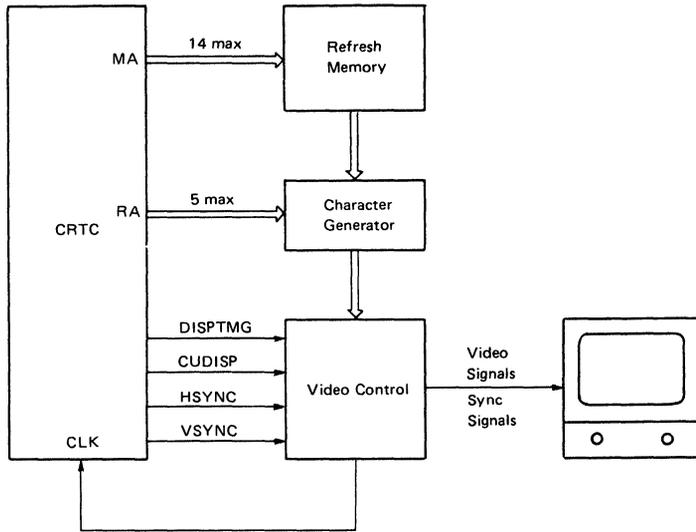


Figure 20 Interface to Display Control Unit

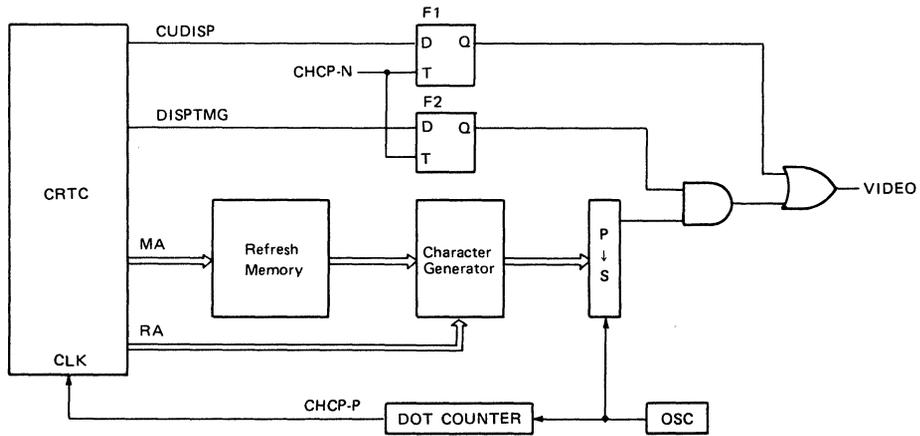


Figure 21 Display Control Unit (1)

When many characters are displayed in horizontal direction on the screen, and horizontal one-character time is so short that both refresh memory and Character Generator cannot be accessed, the circuitry shown in Fig. 22 should be used. In this case refresh memory output shall be latched and Character Generator shall be accessed at the next cycle. The time chart in this case is shown in Fig. 25. CUDISP and DISPTMG should be provided after being delayed by one-character time by using skew bit of interlace & skew register (R8). Moreover, when

there are some troubles about delay time of MA during horizontal one-character time on high-speed display operation, system shown in Fig. 23 is adopted. The time chart in this case is shown in Fig. 26. Character video signal is delayed for two-character time because each MA outputs and refresh memory outputs are latched, and they are made to be in phase with CUDISP and DISPTMG by delaying for two-character time. Table 10 shows the circuitry selection standard of display units.

Table 10 Circuitry Standard of Display Control Unit

Case	Relation among t_{CH} Refresh Memory and Character Generator	Block Diagram	Interlace & Skew Register Bit Programming			
			C1	C0	D1	D0
1	$t_{CH} > RM \text{ Access} + CG \text{ Access} + t_{MAD}$	Fig. 21	0	0	0	0
2	$RM \text{ Access} + CG \text{ Access} + t_{MAD} \geq t_{CH} > RM \text{ Access} + t_{MAD}$	Fig. 22	0	1	0	1
3	$RM \text{ Access} + t_{MAD} \geq t_{CH} > RM \text{ Access}$	Fig. 23	1	0	1	0

t_{CH} : CHCP Period; t_{MAD} : MA Delay

RM: Refresh Memory CG: Character Generator

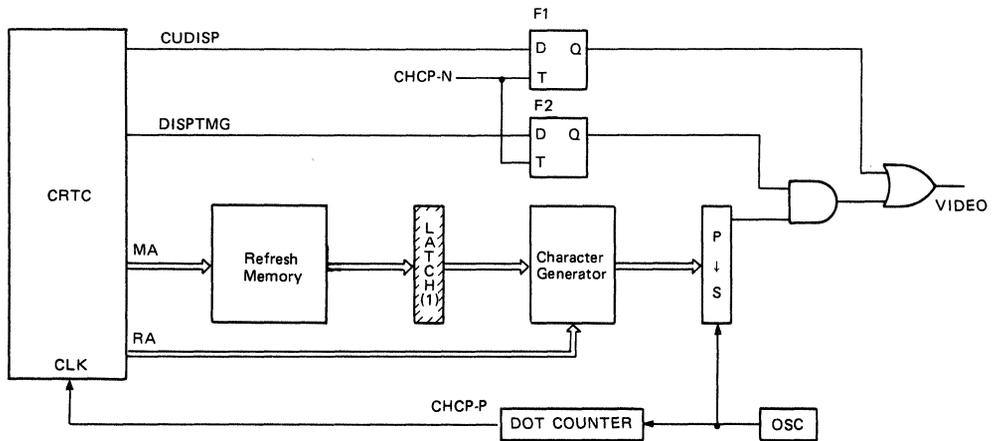


Figure 22 Display Control Unit (2)

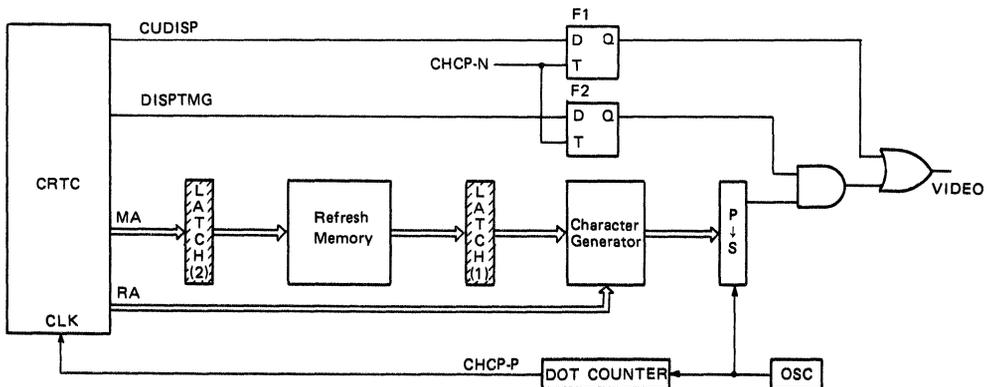


Figure 23 Display Control Unit (For high-speed display operation) (3)

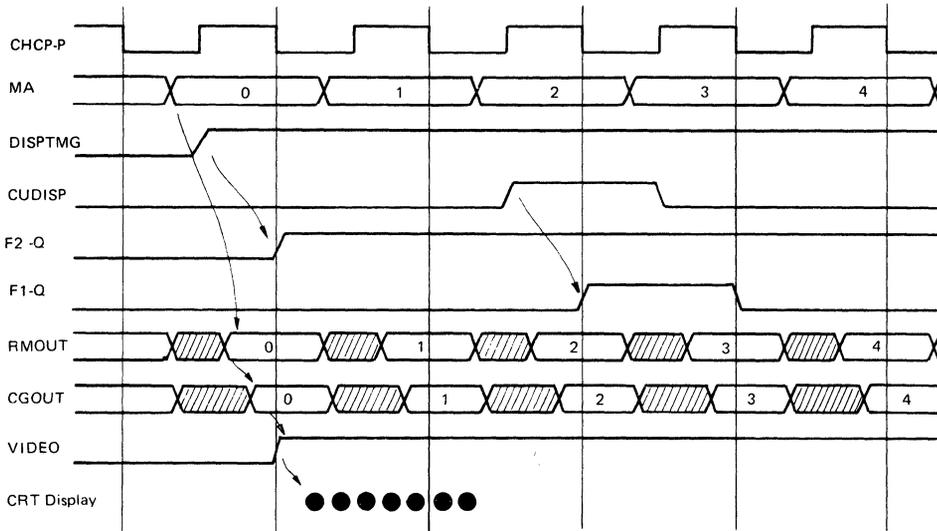


Figure 24 Time Chart of Display Control Unit (1)

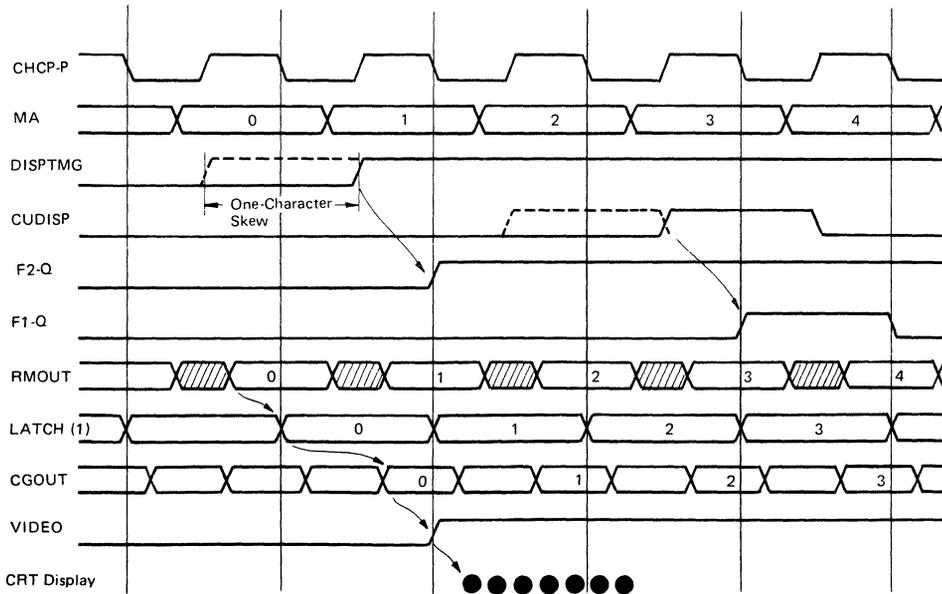


Figure 25 Time Chart of Display Control Unit (2)

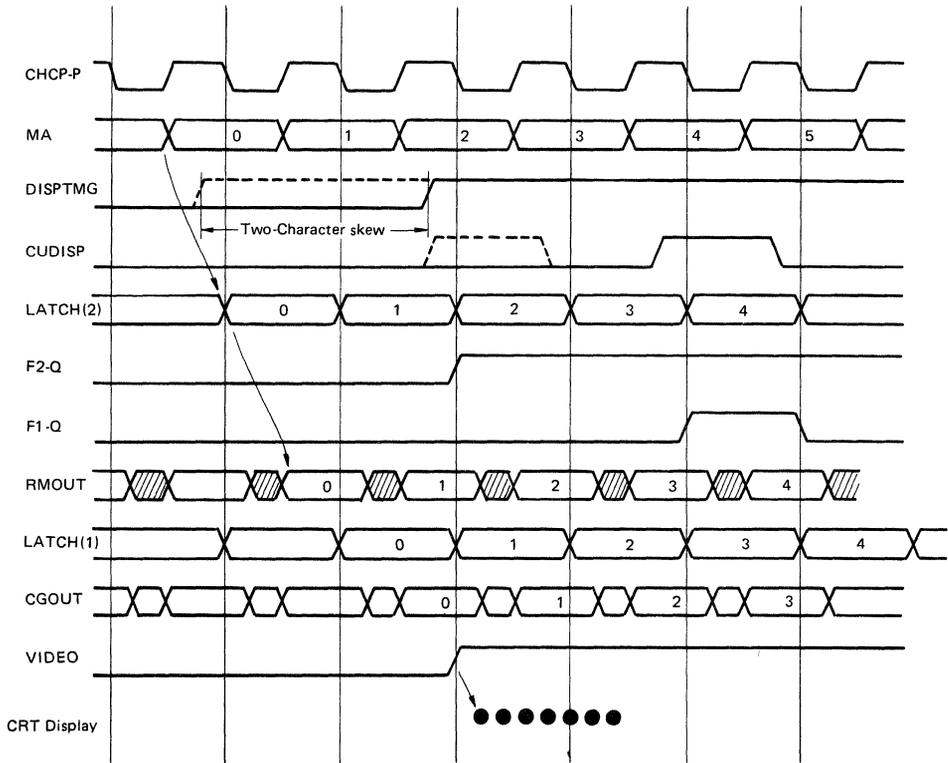


Figure 26 Time Chart of Display Unit (3)

■ HOW TO DECIDE PARAMETERS SET ON THE CRTC

● How to Decide Parameters Based on Specification of CRT Display Unit (Monitor)

Number of Horizontal Total Characters

Horizontal deflection frequency f_h is given by specification of CRT display unit. Number of horizontal total characters is determined by the following equation.

$$f_h = \frac{1}{t_C (Nht + 1)}$$

where,

- t_C : Cycle Time of CLK (Character Clock)
- Nht : Programmed Value of Horizontal Total Register (R0)

Number of Vertical Total Characters

Vertical deflection frequency is given by specification of CRT display unit. Number of vertical Total characters is determined by the following equation.

- 1) Non-interlace Mode
 $Rt = (Nvt + 1) (Nr + 1) + Nadj$
- 2) Interlace Sync Mode
 $Rt = (Nvt + 1) (Nr + 1) + Nadj + 0.5$
- 3) Interlace Sync & Video Mode

$$Rt = \frac{(Nvt + 1) (Nr + 2) + 2Nadj}{2} \dots\dots\dots (a)$$

$$Rt = \frac{(Nvt + 1) (Nr + 2) + 2Nadj + 1}{2} \dots\dots\dots (b)$$

(a) is applied when both total numbers of vertical characters (Nvt + 1) and that of rasters in a line (Nr + 2) are odd.

(b) is applied when total number of rasters (Nr + 2) is even, or when (Nr + 2) is odd and total number of vertical characters (Nvt + 1) is even.

where,

- Rt : Number of Total Rasters per frame (Including retrace period)
- Nvt : Programmed Value of Vertical Total Register (R4)
- Nr : Programmed Value of Maximum Raster Address Register (R9)
- Nadj : Programmed Value of Vertical Total Adjust Register (R5)

Horizontal Sync Pulse Width

Horizontal sync pulse width is programmed to low order 4-bit of horizontal sync width register (R3) in unit of horizontal character time. Programmed value can be selected within from 1 to 15.

Horizontal Sync Position

As shown in Fig. 27, horizontal sync position is normally selected to be in the middle of horizontal retrace period. But there are some cases where its optimum sync position is not located in the middle of horizontal retrace period according to specification of CRT. Therefore, horizontal sync position should be determined by specification of CRT. Horizontal sync pulse position is programmed in unit of horizontal character time.

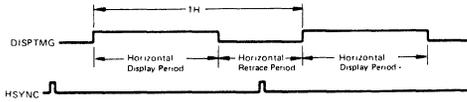


Figure 27 Time Chart of HSYNC

Vertical Sync Pulse Width

Vertical Sync Pulse Width is programmed to high order 4-bit of vertical sync pulse width register (R3) in unit of raster period. Programmed value can be selected within from 1 to 16.

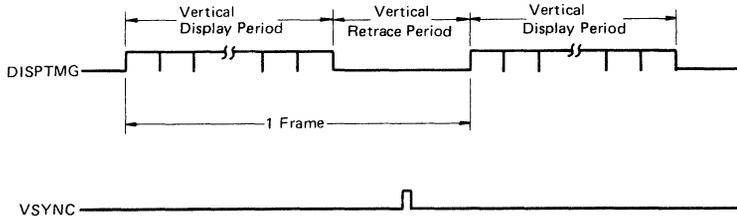


Figure 28 Time Chart of VSYNC

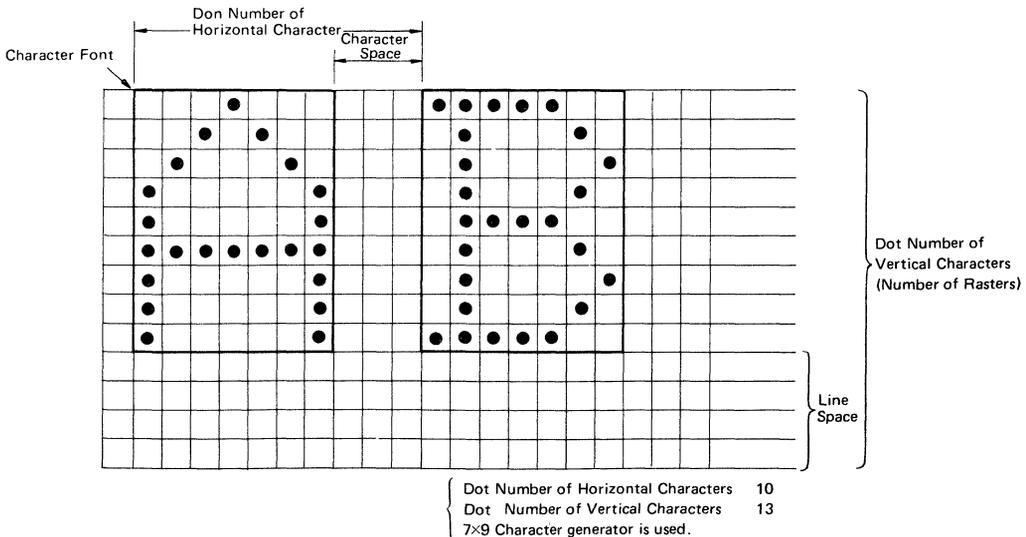


Figure 29 Dot Number of Horizontal and Vertical Characters

Vertical Sync Position

As shown in Fig. 28, vertical sync position is normally selected to be in the middle of vertical retrace period. But there are some cases where its optimum sync position is not located in the middle of vertical retrace period according to specification of CRT. Therefore, vertical sync position should be determined by specification of CRT. Vertical sync pulse position is programmed to vertical sync position register (R7) in unit of line period.

● **How to Decide Parameters Based on Screen Format**

Dot Number of Characters (Horizontal)

Dot number of characters (horizontal) is determined by character font and character space. An example is shown in Fig. 29. More strictly, dot number of characters (horizontal) N is determined by external N-counter. Character space is set by means shown in Fig. 30.

Dot Number of Characters (Vertical)

Dot number of characters (vertical) is determined by characters font and line space. An example is shown in Fig. 29. Dot number of characters (vertical) is programmed to maximum raster address (R9) of CRTC.

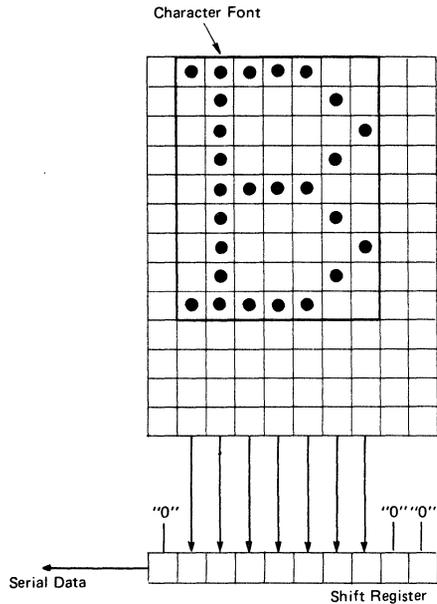


Figure 30 How to Make Character Space

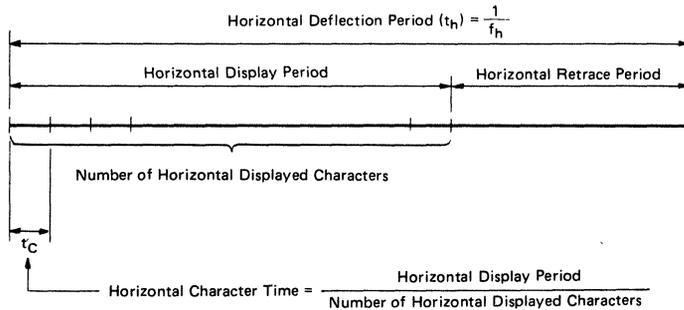


Figure 31 Number of Horizontal Displayed Characters

Number of Horizontal Displayed Characters

Number of horizontal displayed characters is programmed to horizontal displayed register (R1) of the CRTIC. Programmed value is based on screen format. Horizontal display period, which is given by specification of horizontal deflection frequency and horizontal retrace period of CRT display unit, determines horizontal character time, being divided by number of horizontal displayed characters. Moreover, its cycle time and access time which are necessary for CRT display system are determined by horizontal character time.

Number of Vertical Displayed Characters

Number of vertical displayed characters is programmed to vertical displayed register (R6). Programmed value is based on screen format. As specification of vertical deflection frequency of CRT determines number of total rasters (Rt) including verti-

cal retrace period and the relation between number of vertical displayed character and total number of rasters on a screen is as mentioned above, CRT which is suitable for desired screen format should be selected.

For optimum screen format, it is necessary to adjust number of rasters per line, number of vertical displayed characters, and total adjust raster (Nadj) within specification of vertical deflection frequency.

Scan Mode

The CRTIC can program three-scan modes shown in Table 11 to interlace mode register (R8). An example of character display in each scan mode is shown in Fig. 8.

Table 11 Program of Scan Mode

V	S	Scan Mode	Main Usage
0	0	Non-interlace	Normal Display of Characters & Figures
1	0		
0	1	Interlace Sync	Fine Display of Characters & Figures
1	1	Interlace Sync & Video	Display of Many Characters & Figures Without Using High-resolution CRT

[NOTE] In the interlace mode, the number of times per sec. in raster scanning on one spot on the screen is half as many as that in non-interlace mode. Therefore, when persistence of luminescence is short, flickering may happen. It is necessary to select optimum scan mode for the system, taking characteristics of CRT, raster scan speed, and number of displayed characters and figures into account.

Cursor Display Method

Cursor start raster register and cursor end raster register

(R10, R11) enable programming the display modes shown in Table 7 and display patterns shown in Fig. 9. Therefore, it is possible to change the method of cursor display dynamically according to the system conditions as well as to realize the cursor display that meets the system requirements.

Start Address

Start address registers (R12, R13) give an offset to the address of refresh memory to read out. This enables paging and scrolling easily.

Cursor Register

Cursor registers (R14, R15) enable programming the cursor display position on the screen. As for cursor address, it is not X, Y address but linear address that is programmed.

■ **Applications of the CRTC**

● **Monochrome Character Display**

Fig. 32 shows a system of monochrome character display. Character clock signal (CLK) is provided to the CRTC through OSC and dot counter. It is used as basic clock which drives internal control circuits. MPU is connected with the CRTC by standard bus and controls the CRTC initialization and read/write of internal registers.

Refresh memory is composed of RAM which has capacity of one frame at least and the data to be displayed is coded and stored. The data to refresh memory is changed through MPU

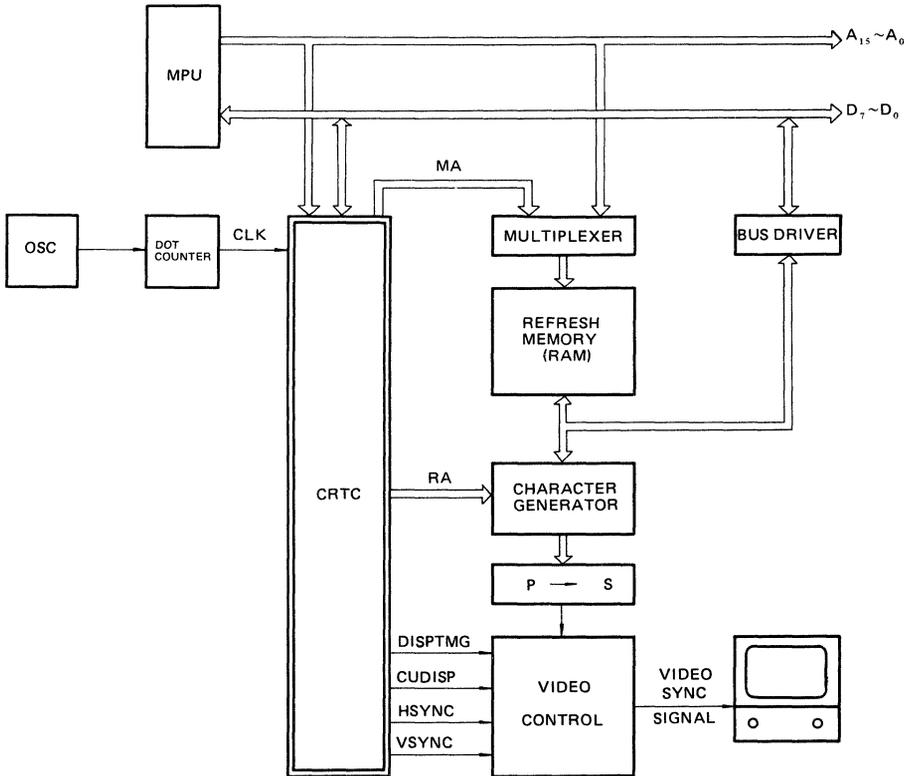


Figure 32 Monochrome Character Display

bus, while refresh memory is read out successively by the CRTC to display a static pattern on the screen. Refresh memory is accessed by both MPU and the CRTC, so it needs to change its address selectively by multiplexer. The CRTC has 14 MA (Memory Address output), but in fact some of them that are needed are used according to capacity of refresh memory.

Code output of refresh memory is provided to character generator. Character generator generates a dot pattern of a specified raster of a specified character in parallel according to code output from refresh memory and RA (Raster Address output) from the CRTC. Parallel-serial converter is normally composed of shift register to convert output of character generator into a serial dot pattern. Moreover, DISPTMG,

CUDISP, HSYNC, and VSYNC are provided to video control circuit. It controls blanking for output of parallel-serial converter, mixes these signals with cursor video signal, and generates sync signals for an interface to monitor.

● **Color Character Display**

Fig. 33 shows a system of color character display. In this example, a 3-bit color control bit (R, G, B) is added to refresh memory in parallel with character code and provided to video control circuit. Video control circuit controls coloring as well as blanking and provides three primary color video signals (R, G, B signals) to CRT display device to display characters in seven kinds of color on the screen.

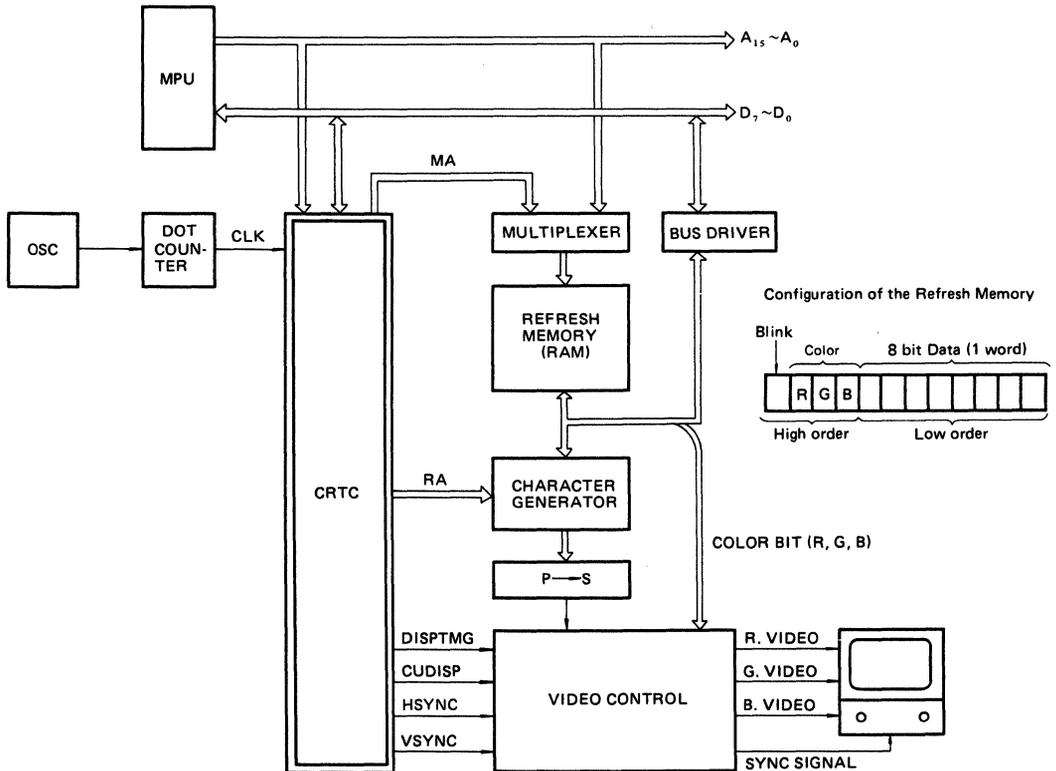


Figure 33 Color Character Display

● **Color limited Graphic Display**

Limited graphic display is to display simple figures as well as character display by combination of picture element which are defined in unit of one character.

As shown in Fig. 34, graphic pattern generator is set up in parallel with character generator and output of these generators are wire-ORed. Which generator is accessed depends on

coded output of refresh memory.

In this example, graphic-pattern generator adopts ROM, so only the combination of picture elements which are programmed to it is used for this graphic display system. Adopting RAM instead of ROM enables dynamically writable symbols in any combination on one display by changing the contents of them.

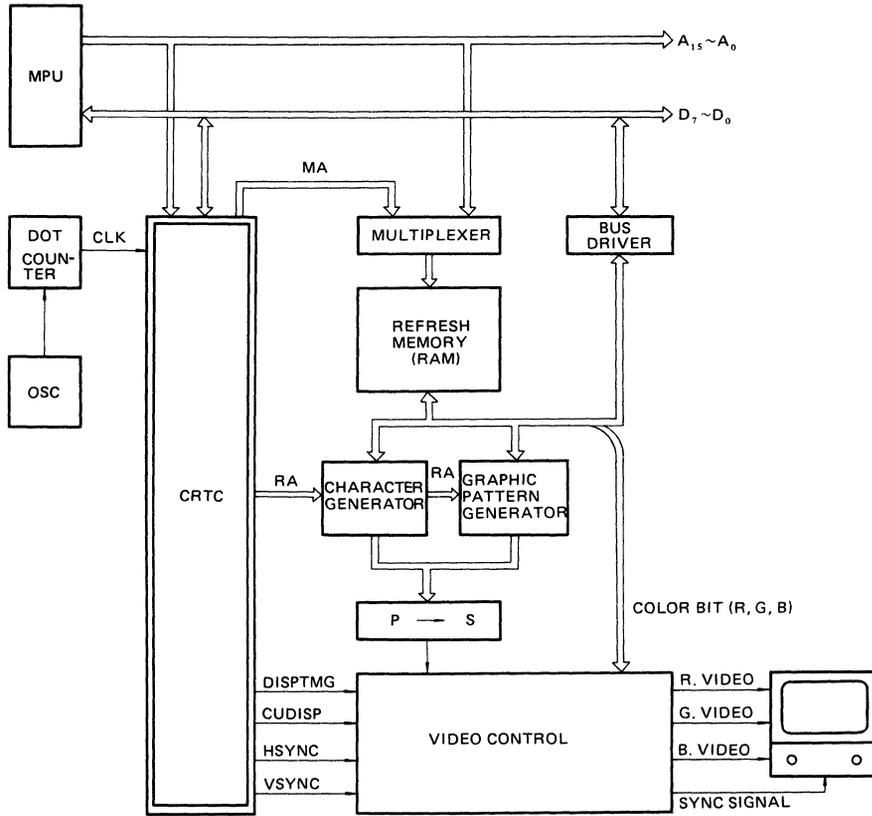


Figure 34 Color Limited Graphic Display

● **Monochrome Full Graphic Display**

Fig. 35 shows a system of monochrome full graphic display. While simple graphic display is figure display by combination of picture elements in unit of 1 picture elements, full graphic display is display of any figures in unit of 1 dot. In this case,

refresh memory is dot memory that stores all the dot patterns, so its output is directly provided to parallel-serial converter to be displayed. Dot memory address to refresh the screen is set up by combination of MA and RA of CRTIC.

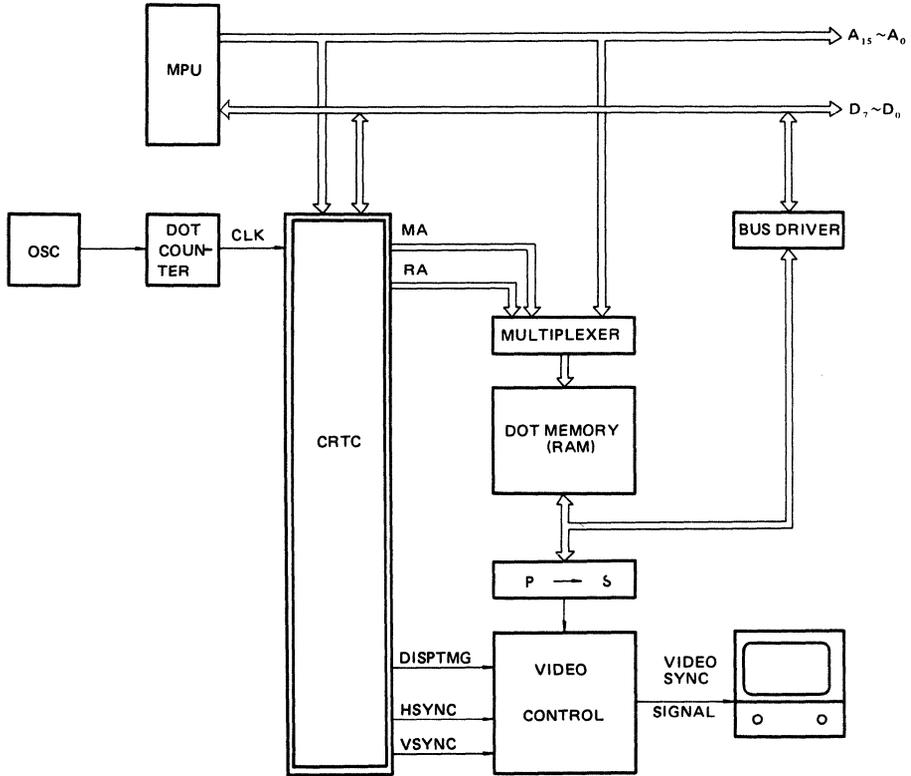


Figure 35 Monochrome Full Graphic Display

Fig. 36 shows an example of access to refresh memory by combination of MA and RA. Fig. 36 shows a refresh memory address method for full graphic display.

Correspondence between dot on the CRT screen and refresh memory address is shown in Fig. 37.

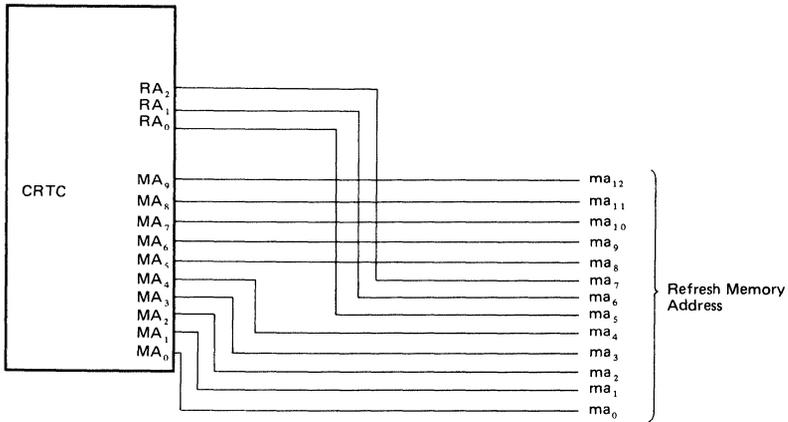


Figure 36 Refresh Memory Address Method for Full Graphic Display

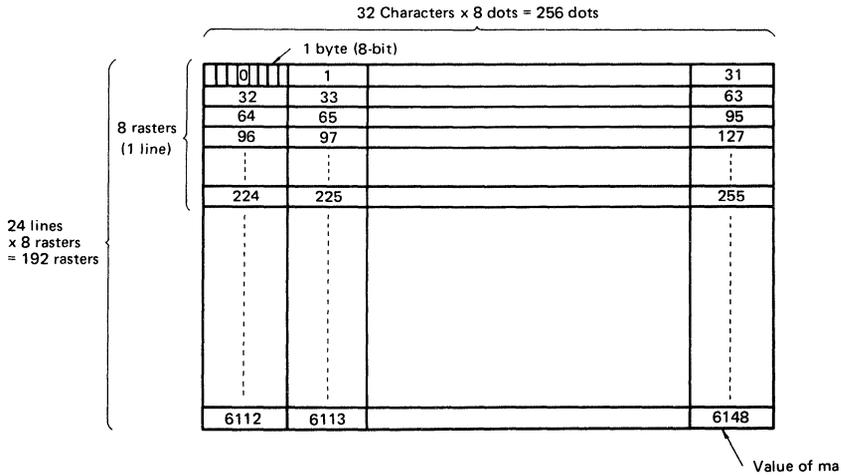


Figure 37 Memory Address and Dot Display Position on the Screen for Full Graphic Display

• **Color Full Graphic Display**

Fig. 38 shows a system of color full graphic display by 7-color display. Refresh memory is composed of three dot memories which are respectively used for red, green, and blue. These dot memories are read out in parallel at one time and

their output is provided to three parallel-serial converters. Then video control circuit adds the blanking control to output of these converters and provides it to CRT display device as red, green, and blue video signals with sync signals.

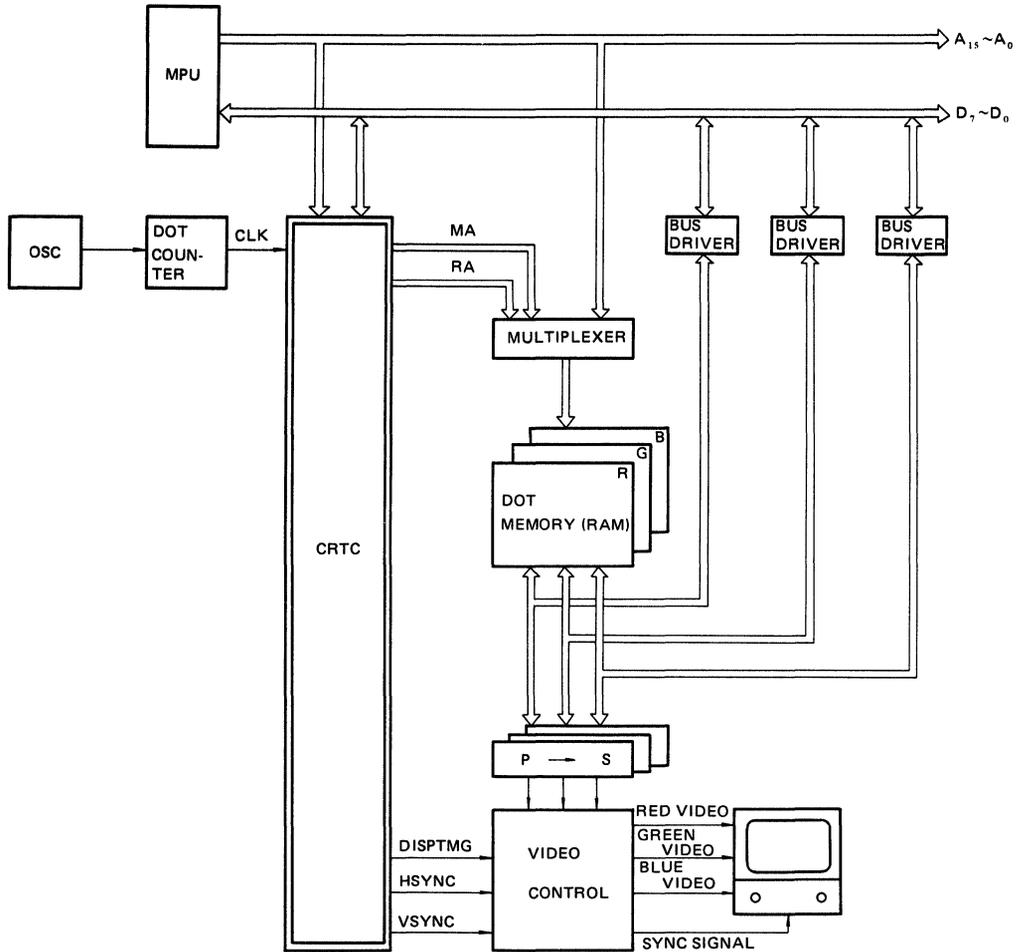


Figure 38 Color Full Graphic Display

• **Cluster Control of CRT Display**

The CRTC enables cluster control that is to control CRT display of plural devices by one CRTC. Fig. 39 shows a system of cluster control. Each display control unit has refresh memory, character generator, parallel-serial converter, and video control

circuit separately, but these are controlled together by the CRTC.

In this system, it is possible for plural CRT display devices to have their own display separately.

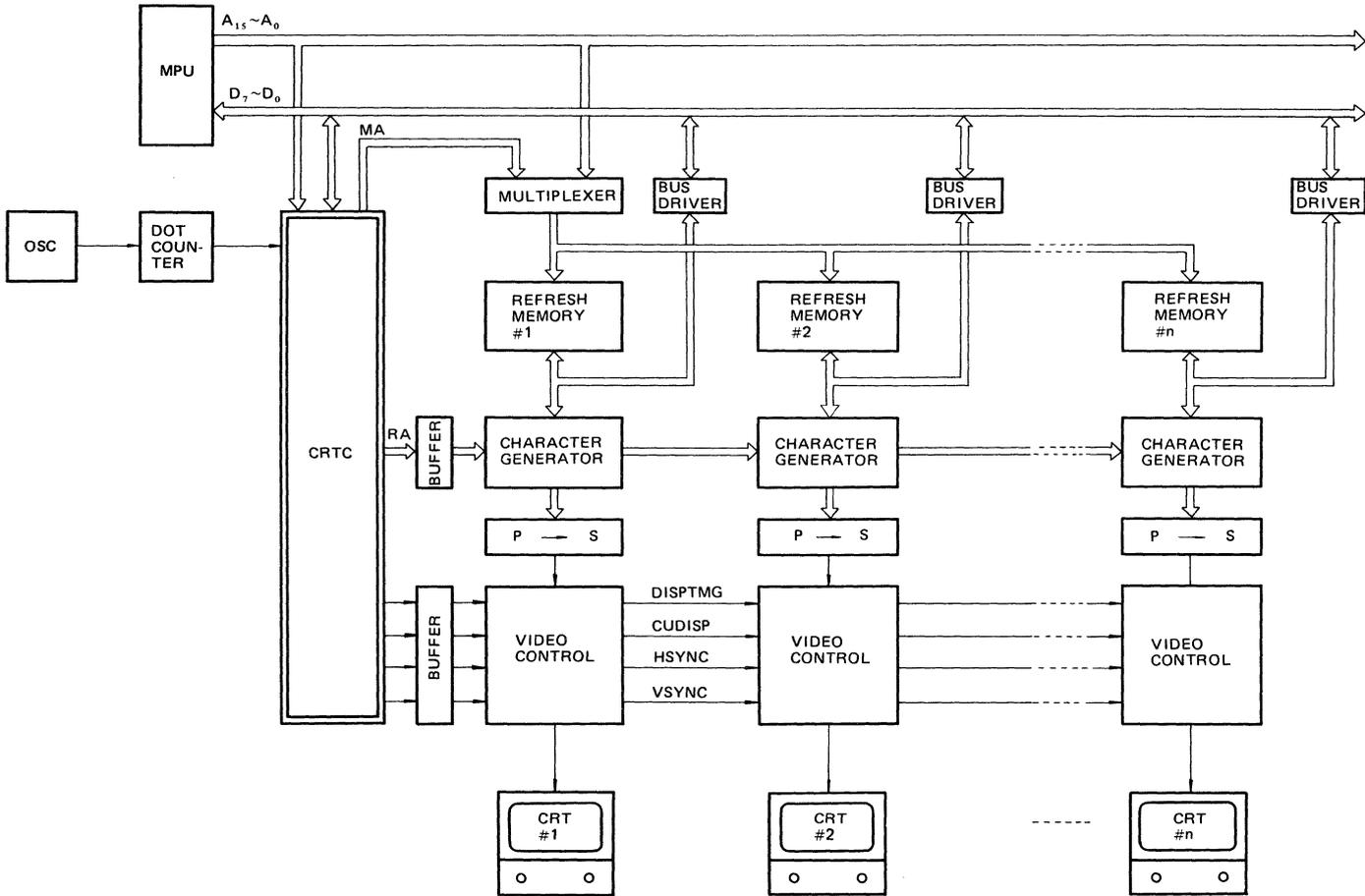


Figure 39 Cluster Control by the CRTC

■ EXAMPLES OF APPLIED CIRCUIT OF THE CRTC

Fig. 41 shows an example of application of the CRTC to monochrome character display. Its specification is shown in

Table 12. Moreover, specification of CRT display unit is shown in Table 13 and initializing values for the CRTC are shown in Table 14.

Table 12 Specification of Applied Circuit

Item	Specification																																																																	
Character Format	5 × 7 Dot																																																																	
Character Space	Horizontal : 3 Dot Vertical : 5 Dot																																																																	
One Character Time	1 μs																																																																	
Number of Displayed Characters	40 characters × 16 lines = 640 characters																																																																	
Access Method to Refresh Memory	Synchronous Method (DISPTMG Read)																																																																	
Refresh Memory	640 B																																																																	
Address Map	<table style="border: none; width: 100%;"> <tr> <td></td> <td>2¹⁵</td> <td>2¹⁴</td> <td>2¹³</td> <td>2¹²</td> <td>2¹¹</td> <td>2¹⁰</td> <td>2⁹</td> <td>2⁸</td> <td>2⁷</td> <td>2⁶</td> <td>2⁵</td> <td>2⁴</td> <td>2³</td> <td>2²</td> <td>2¹</td> <td>2⁰</td> </tr> <tr> <td>Refresh Memory</td> <td>0</td> <td>0</td> <td>0</td> <td>0</td> <td>0</td> <td>0</td> <td>*</td> <td>*</td> <td>*</td> <td>*</td> <td>*</td> <td>*</td> <td>*</td> <td>*</td> <td>*</td> </tr> <tr> <td>CRTC Address Register</td> <td>0</td> <td>0</td> <td>0</td> <td>1</td> <td>0</td> <td>0</td> <td>×</td> <td>×</td> <td>×</td> <td>×</td> <td>×</td> <td>×</td> <td>×</td> <td>×</td> <td>0</td> </tr> <tr> <td>CRTC Control Register</td> <td>0</td> <td>0</td> <td>0</td> <td>1</td> <td>0</td> <td>0</td> <td>×</td> <td>×</td> <td>×</td> <td>×</td> <td>×</td> <td>×</td> <td>×</td> <td>×</td> <td>1</td> </tr> </table>		2 ¹⁵	2 ¹⁴	2 ¹³	2 ¹²	2 ¹¹	2 ¹⁰	2 ⁹	2 ⁸	2 ⁷	2 ⁶	2 ⁵	2 ⁴	2 ³	2 ²	2 ¹	2 ⁰	Refresh Memory	0	0	0	0	0	0	*	*	*	*	*	*	*	*	*	CRTC Address Register	0	0	0	1	0	0	×	×	×	×	×	×	×	×	0	CRTC Control Register	0	0	0	1	0	0	×	×	×	×	×	×	×	×	1
		2 ¹⁵	2 ¹⁴	2 ¹³	2 ¹²	2 ¹¹	2 ¹⁰	2 ⁹	2 ⁸	2 ⁷	2 ⁶	2 ⁵	2 ⁴	2 ³	2 ²	2 ¹	2 ⁰																																																	
	Refresh Memory	0	0	0	0	0	0	*	*	*	*	*	*	*	*	*																																																		
	CRTC Address Register	0	0	0	1	0	0	×	×	×	×	×	×	×	×	0																																																		
CRTC Control Register	0	0	0	1	0	0	×	×	×	×	×	×	×	×	1																																																			
	× . . . don't care, * . . . 0 or 1																																																																	
Synchronization Method	HVSYNC Method																																																																	

Table 13 Specification of Character Display

Item	Specification
Scan Mode	Non-interlace
Horizontal Deflection Frequency	15.625 kHz
Vertical Deflection Frequency	60.1 Hz
Dot Frequency	8 MHz
Character Dot (Horizontal × Vertical)	8 × 12 (Character Font 5 × 7)
Number of Displayed Characters (Row × Line)	40 × 16
HSYNC Width	4 μs
VSYNC Width	3 H
Cursor Display	Raster 9 ~ 10, Blink 16 Field Period
Paging, Scrolling	Not used

Table 14 Initializing Values for Character Display

Register	Name	Symbol	Initializing Value Hex (Decimal)
R0	Horizontal Total	Nht	3F (63)
R1	Horizontal Displayed	Nhd	28 (40)
R2	Horizontal Sync Position	Nhsp	34 (52)
R3	Sync Width	Nvsw, Nhsw	34
R4	Vertical Total	Nvt	14 (20)
R5	Vertical Total Adjust	Nadj	08 (8)
R6	Vertical Displayed	Nvd	10 (16)
R7	Vertical Sync Position	Nvsp	13 (19)
R8	Interlace & Skew		00
R9	Maximum Raster Address	Nr	0B (11)
R10	Cursor Start Raster	B, P, NCSTART	49
R11	Cursor End Raster	NCEND	0A (10)
R12	Start Address (H)		00 (0)
R13	Start Address (L)		00 (0)
R14	Cursor (H)		00 (0)
R15	Cursor (L)		00 (0)

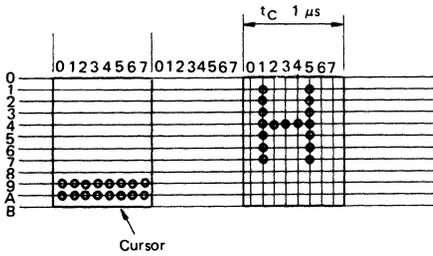


Figure 40 Non-interlace Display (Example)

- **DISPLAY SEQUENCE AFTER $\overline{\text{RES}}$ RELEASE OF HD6845S** (1) DISPTMG and CUDISP are not output. (They remain at "Low" level. The display is inhibited.)
- HD6845S starts the display operation immediately after the release of $\overline{\text{RES}}$. The operation at the first field is different from the normal subsequent display operation. (2) The data programmed in the start address register is not used. (MA and RA start at "0".)
- [Operation at the first field after the $\overline{\text{RES}}$ release] (3) The sequences are shown in the following figures.

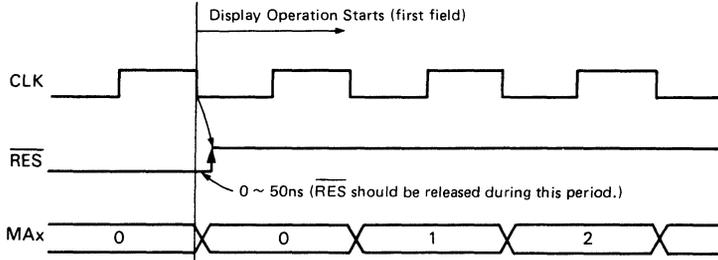


Figure 42 $\overline{\text{RES}}$ Release Sequence

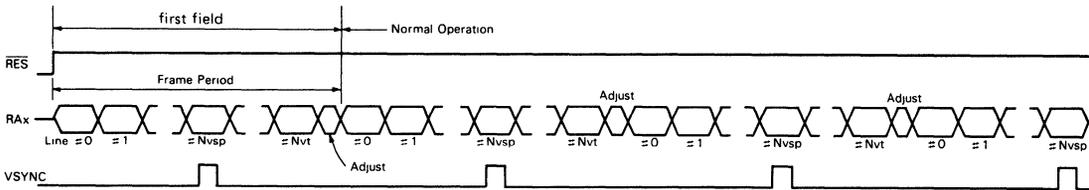
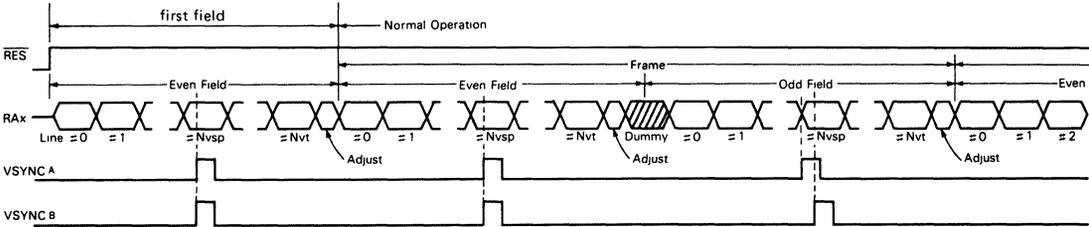
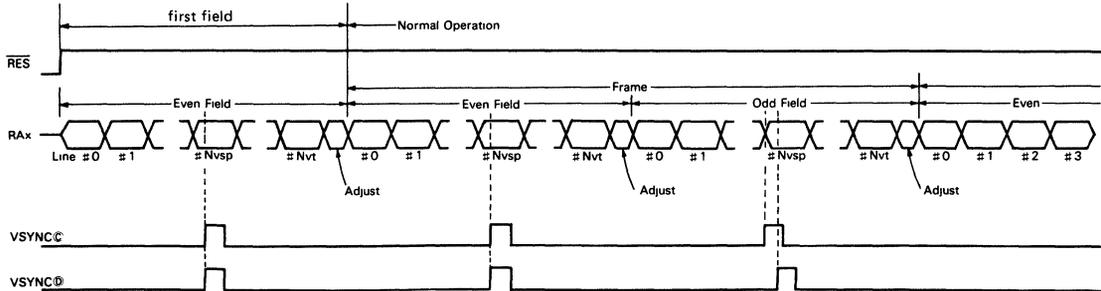


Figure 43 $\overline{\text{RES}}$ Release Sequence in The Non-interlace Mode



VSYNC A : Interlace Sync Control
 Interlace Sync & Video Control (Nr+2=Even)
 Interlace Sync & Video Control (Nr+2=Odd, Nvt=Odd, Nvsp=Even)
 VSYNC B : Interlace Sync & Video Control (Nr+2=Odd, Nvt=Odd, Nvsp=Odd)

Figure 44 $\overline{\text{RES}}$ Release Sequence in The Interlace Mode (1)



VSYNC C : Interlace Sync & Video Control (Nr+2=Odd, Nvt=Even, Nvsp=Even)
 VSYNC D : Interlace Sync & Video Control (Nr+2=Odd, Nvt=Even, Nvsp=Odd)

Figure 45 $\overline{\text{RES}}$ Release Sequence in The Interlace Mode (2)

■ ANOMALOUS OPERATIONS IN HD6845S CAUSED BY REWRITING REGISTERS DURING THE DISPLAY OPERATION*

Register #	Register Name	Anomalous operations caused by rewriting registers & Conditions to avoid those operations	Rewriting** OK or NG
R0	Horizontal Total	The horizontal scan period is disturbed.	X
R1	Horizontal Displayed	There are some cases where the width of DISPTMG becomes shorter than the programmed value at the moment of a rewrite operation. An error operation occurs only during one raster period.	○
R2	Horizontal Sync Position	There are some cases where HSYNC is placed on the position different from the programmed value or the noise is output.	X
R3	Sync Width	When a rewrite operation is performed at a "High" level on HSYNC pulse or VSYNC pulse, there are some cases where the width pulse becomes shorter than the programmed value at the moment of a rewrite operation.	△
R4	Vertical Total	When a rewrite operation is performed during the last raster period in the line, there is a possibility that the disturbance occurs during the vertical scan period. There is no problem of a rewrite operation during raster period except this period.	△
R5	Vertical Total Adjust	When a rewrite operation is performed in the last character time of the raster period, there are some cases where the numbers of Adjust Raster, specified by program, are not added. (Only during the adjust raster period)	△
R6	Vertical Displayed	After the moment of a rewrite operation, there are some cases where the Display is inhibited. However, the display according to the programmed value is performed from the next field.	○
R7	Vertical Sync Position	There are some cases where VSYNC is placed on the position different from the programmed value or the noise is output.	X
R8	Interlace & Skew	Neither scan mode bit nor skew bit is rewritten dynamically. Dynamic Rewrite into scan mode bit and skew bit is prohibited.	X
R9	Maximum Raster Address	The internal operation will be disordered by a rewrite operation.	X
R10	Cursor Start Raster	When a rewrite operation is performed in the last character time of the raster period, there are some cases where the jitter occurs on the cursor raster or the cursor is not displayed correctly. There is also a possibility that the blink rate becomes temporarily shorter than usual.	△
R11	Cursor End Raster	When a rewrite operation is performed in the last character time of the raster period, there are some cases where the jitter occurs on the cursor raster or the cursor is not displayed correctly. Moreover, there are also some cases where the blink rate becomes temporarily shorter than normal operation.	△
R12	Start Address (H)	R12 and R13 are used in the last raster period of the field. A rewrite operation can be performed except during this period. However, when R12 and R13 are rewritten in each field separately, the display operation, whose start address is determined temporarily by programming sequence, will be performed. A rewrite operation should be performed during the horizontal/vertical display period.	○
R13	Start Address (L)		○
R14	Cursor (H)	When a rewrite operation is performed during the display period, there are some cases where the cursor is temporarily displayed at the address different from the programmed value. A rewrite operation should be performed during the horizontal/vertical retrace period. Also, when R14 and R15 are rewritten in each field separately, the cursor is displayed temporarily at the temporal address determined by programming sequence.	○
R15	Cursor (L)		○

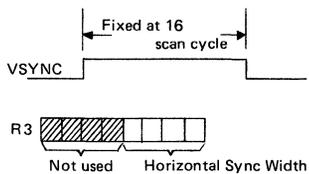
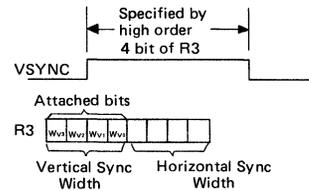
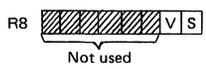
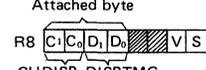
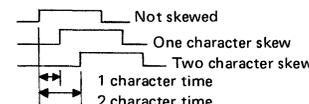
* means temporary abnormal operations in rewriting the internal register during the display operation. Normally, after a rewrite operation, the LSI performs the specified display operation from the next field.
 (The operations in this table are outside our guarantee and are regarded as materials for reference.)

- A rewrite operation is possible without affecting the screen in the display so much.
- ** { △ If conditions are satisfied, a rewrite operation is possible. If conditions are not satisfied, there are some cases where a flicker and so on occur temporarily.
- X When a rewrite operation is performed, there are some cases where a flicker and so on occur temporarily.

■ **COMPARISON BETWEEN HD6845S AND HD6845**
 ● **Comparison of function between HD6845S and HD6845**

No.	Functional Difference	HD6845	HD6845S
1	Interface Sync & Video Mode Display	<p>Programming Method of Number of Vertical Characters</p> <p>In HD6845, number of characters is vertically programmed in unit of two lines, as illustrated above. (Number of vertical total characters, Number of vertical displayed characters, Vertical Sync Position)</p> <p>Example of above figure</p> <p>Programmed number into Vertical Displayed Register = 5</p>	<p>Programming Method of Number of Vertical Characters</p> <p>In HD6845S, number of characters is vertically programmed in unit of one line, as illustrated above. (Number of vertical total characters, Number of vertical displayed characters, Vertical Sync Position)</p> <p>Example of above figure</p> <p>Programmed number into Vertical Displayed Register = 10</p>
	Number of Rasters Per Character Line	<p>Only even number can be specified.</p> <p>Number of raster</p> <p>Character line address 0</p> <p>Number of raster = 10 scan line (specified)</p> <p>However, number which is programmed into register is calculated as follows.</p> <p>Programmed number (Nr) = (Number specified) - 1</p>	<p>Both even number and odd number can be specified.</p> <p>Character line address 0</p> <p>Character line address 1</p> <p>When number of raster per character line is EVEN. Number of raster = 10 scan line (specified)</p> <p>When number of raster per character line is ODD. Number of raster = 9 scan line (specified)</p> <p>However, number which is programmed into register is calculated as follows.</p> <p>Programmed number (Nr) = (Number specified) - 2</p>
	Cursor Display	<p>Cursor is displayed in either EVEN field or ODD field.</p> <p>← EVEN number</p> <p>← EVEN number</p> <p>← ODD number</p> <p>← ODD number</p>	<p>Cursor is displayed in both EVEN field and ODD field.</p> <p>← EVEN number</p> <p>← EVEN number</p> <p>← ODD number</p> <p>← ODD number</p> <p>← EVEN number</p> <p>← ODD number</p>

(to be continued)

No.	Functional Difference	HD6845	HD6845S
2	Vertical Sync Pulse Width (VSYNC output)	Fixed at 16 raster scan cycle (16H) 	Programmable (1 ~ 16 raster scan cycle) 
3	SKEW Function	Not included 	SKEW function is newly included in DISPTMG, CUDISP signals.  Attached byte Example of DISPTMG output 
4	Start Address Register	Impossible to READ	Possible to READ
5	RESET Signal ($\overline{\text{RES}}$)	$\left. \begin{array}{l} \text{MA}_0 \sim \text{MA}_{13} \text{ Output} \\ \text{RA}_0 \sim \text{RA}_4 \text{ Output} \\ \text{Other Outputs} \end{array} \right\} \dots \dots \text{Synchronous reset}$ $\dots \dots \dots \text{Asynchronous reset}$ Output signals of $\text{MA}_0 \sim \text{MA}_{13}$, $\text{RA}_0 \sim \text{RA}_4$, synchronizing with DLK "Low" level, go to "Low" level, after $\overline{\text{RES}}$ has gone to "Low". Other outputs go to "Low" immediately after $\overline{\text{RES}}$ has gone to "Low" level	$\left. \begin{array}{l} \text{MA}_0 \sim \text{MA}_{13} \text{ Output} \\ \text{RA}_0 \sim \text{RA}_4 \text{ Output} \\ \text{Other Outputs} \end{array} \right\} \dots \dots \text{Asynchronous reset}$ Output signals of $\text{MA}_0 \sim \text{MA}_{13}$, $\text{RA}_0 \sim \text{RA}_4$ and others go to "Low" level immediately after $\overline{\text{RES}}$ has gone to "Low" level.

• Comparison of Timing Signal between HD6845S and HD6845

No.	Item	Symbol	HD6845			HD6845S			Unit
			min	typ	max	min	typ	max	
1	Clock Cycle Time	t_{cycC}	330	—	—	270	—	—	ns
2	Clock "High" Pulse Width	PW_{CH}	150	—	—	130	—	—	ns
3	Clock "Low" Pulse Width	PW_{CL}	150	—	—	130	—	—	ns
4	Rise and Fall Time for Clock Input	$t_{\text{Cr}}, t_{\text{Cf}}$	—	—	15	—	—	20	ns
5	Horizontal Sync Delay Time	t_{HSD}	—	—	250	—	—	200	ns
6	Light Pen Strobe Pulse Width	PW_{LPH}	80	—	—	60	—	—	ns
7	Light Pen Strobe Uncertain Time of Acceptance	t_{LPD1}	—	—	80	—	—	70	ns
		t_{LPD2}	—	—	10	—	—	0	ns

■ COMPATIBILITY OF HD6845S AND HD6845

Non-interlace mode control } Fully compatible with HD6845*
 Interlace sync mode control } HD6845 can be directly replaced by HD6845S in these modes.
 Interlace sync & Video mode control : Not compatible with HD6845 in regard to programming and

data for vertical direction need to be changed.

* The functions added to HD6845S utilize undefined bits of the Control Register in HD6845. If "0" is programmed to the undefined bits in the initial set, it is possible to replace HD6845 with HD6845S without changing the parameters.
 Note) The restriction on programming of HD6845S and HD6845 should be taken into consideration.

HD6846

COMBO (Combination ROM I/O Timer)

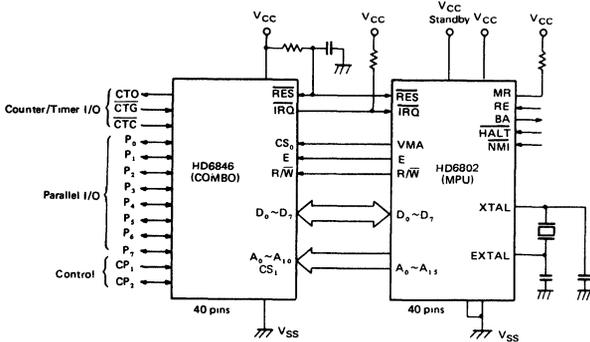
The HD6846 combination chip provides the means, in conjunction with the HD6802, to develop a basic 2-chip microcomputer system. The HD6846 consists of 2048 bytes of mask-programmable ROM, an 8-bit bidirectional data port with control lines, and a 16-bit programmable timer-counter.

This device is capable of interfacing with the HD6802 (basic HD6800, clock and 128 bytes of RAM) as well as the HD6800 if desired. No external logic is required to interface with most peripheral devices.

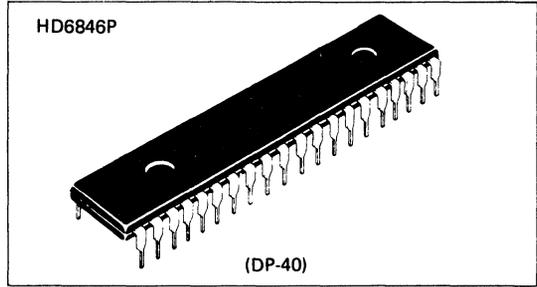
■ FEATURES

- 2048 Bytes of Mask-Programmable ROM
- 8-Bit Bidirectional Data Port for Parallel Interface plus Two Control Lines
- Programmable Interval Timer-Counter Functions
- Programmable I/O Peripheral Data, Control and Direction Registers
- Compatible with the Complete HMCS6800 Microcomputer Product Family
- TTL-Compatible Data and Peripheral Lines
- Single 5-Volt Power Supply
- Compatible with MC6846

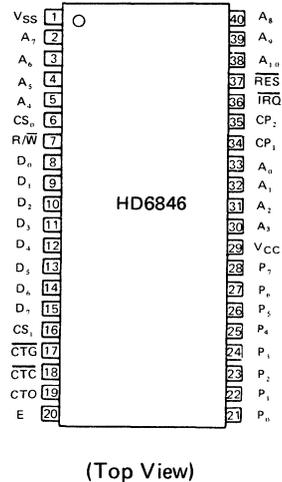
■ TYPICAL MICROCOMPUTER



This is a block diagram of a typical cost effective microcomputer. The MPU is the center of the microcomputer system and is shown in a minimum system interfacing with a ROM combination chip. It is not intended that this system be limited to this function but that it be expandable with other parts in the HMCS6800 Microcomputer family.



■ PIN ARRANGEMENT



■ ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Value	Unit
Supply Voltage	V _{CC} *	-0.3 ~ +7.0	V
Input Voltage	V _{in} *	-0.3 ~ +7.0	V
Operating Temperature	T _{opr}	-20 ~ +75	°C
Storage Temperature	T _{stg}	-55 ~ +150	°C

* With respect to V_{SS} (SYSTEM GND)

(NOTE) Permanent LSI damage may occur if maximum ratings are exceeded. Normal operation should be under recommended operating conditions. If these conditions are exceeded, it could affect reliability of LSI.

■ RECOMMENDED OPERATING CONDITIONS

Item	Symbol	min	typ	max	Unit
Supply Voltage	V _{CC} *	4.75	5.0	5.25	V
Input Voltage	V _{IL} *	-0.3	—	0.8	V
	V _{IH} *	2.0	—	V _{CC}	V
Operating Temperature	T _{opr}	-20	25	75	°C

* With respect to V_{SS} (SYSTEM GND)

■ ELECTRICAL CHARACTERISTICS

● DC CHARACTERISTICS (V_{CC}=5.0V±5%, V_{SS}=0V, Ta=-20~+75°C, unless otherwise noted.)

Item	Symbol	Test Condition	min	typ	max	Unit	
Input "High" Voltage	V _{IH}		2.0	—	V _{CC}	V	
Input "Low" Voltage	V _{IL}		-0.3	—	0.8	V	
Clock Overshoot/Undershoot	V _{OS}	Input "High" Level	V _{CC}	—	V _{CC} +0.5	V	
		Input "Low" Level	V _{SS}	—	V _{SS} +0.5		
Input Leakage Current	I _{in}	V _{in} = 0 ~ 5.25V	-2.5	—	2.5	μA	
Three-State (Off State) Input Current	I _{TSI}	V _{in} = 0.4 ~ 2.4V	-10	—	10	μA	
Output "High" Voltage	V _{OH}	D ₀ ~D ₇ , P ₀ ~P ₇ , CP ₂	I _{OH} = -205μA	2.4	—	V	
		CTO	I _{OH} = -200μA	2.4	—	V	
			I _{OH} = -200μA	2.4	—	V	
Output "Low" Voltage	V _{OL}	D ₀ ~D ₇	I _{OL} = 1.6mA	—	0.4	V	
		Other Outputs	I _{OL} = 3.2mA	—	0.4	V	
Output "High" Current (Sourcing)	I _{OH}	D ₀ ~D ₇	V _{OH} = 2.4V	-205	—	μA	
		CTO, CP ₂ , P ₀ ~P ₇	V _{OH} = 2.4V	-200	—	μA	
Output "High" Current (Sourcing) (the current for driving other than TTL, e.g., Darlington Base)	I _{OH}	V _{OH} = 1.5V	-1.0	—	-10	mA	
Output "Low" Current (Sinking)	I _{OL}	D ₀ ~D ₇	V _{OL} = 0.4V	1.6	—	mA	
		Other Outputs	V _{OL} = 0.4V	3.2	—	mA	
Output Leakage Current (Off State)	I _{LOH}	V _{OH} = 2.4V	—	—	10	μA	
Power Dissipation	P _D		—	—	800	mW	
Capacitance	E	C _{in}	V _{CC} = 0V V _{in} = 0V T _a = 25°C f = 1MHz	—	—	20	pF
	D ₀ ~D ₇	C _{in}		—	—	12.5	pF
	P ₀ ~P ₇ , CP ₂ , CTO	C _{out}		—	—	10	pF
	A ₀ ~A ₁₀ , R/ \bar{W}	C _{in}		—	—	7.5	pF
	\bar{RES} , CS ₀ , CS ₁ , CP ₁ , CTG	C _{in}		—	—	10	pF
	\bar{IRQ}	C _{out}		—	—	7.5	pF

● AC CHARACTERISTICS ($V_{CC}=5.0V\pm 5\%$, $V_{SS}=0V$, $T_a=-20\sim+75^\circ C$, unless otherwise noted.)

1. BUS TIMING

Item	Symbol	Test Condition	min	typ	max	Unit
Enable Cycle Time	t_{cycE}	Fig. 1	1.0	—	10	μs
Enable Pulse Width, "Low"	PW_{EL}		430	—	4500	ns
Enable Pulse Width, "High"	PW_{EH}		430	—	4500	ns
Address Set Up Time	t_{AS}		140	—	—	ns
Data Delay Time	t_{DDR}		—	—	320	ns
Data Hold Time	t_H		10	—	—	ns
Address Hold Time	t_{AH}		10	—	—	ns
Enable Rise and Fall Time	t_{Ef}, t_{Er}		—	—	25	ns
Data Set Up Time	t_{DSW}		195	—	—	ns
Reset "Low" Time	t_{RL}		—	2	—	μs
Interrupt Release Time	t_{IR}	Fig. 2	—	—	1.6	μs

2. PARALLEL PERIPHERAL I/O LINE TIMING

Item	Symbol	Test Condition	min	typ	max	Unit
Peripheral Data Setup Time	t_{PDSU}	Fig. 3	200	—	—	ns
Rise and Fall Times CP_1, CP_2	t_{Pr}, t_{Pf}	Fig. 5	—	—	1.0	μs
Delay Time E to CP_2 Fall	t_{CP2}	Fig. 4	—	—	1.0	μs
Delay Time I/O Data CP_2 Fall	t_{DC}		20	—	—	ns
Delay Time E to CP_2 Rise	t_{RS1}	Fig. 5	—	—	1.0	μs
Delay Time CP_1 to CP_2 Rise	t_{RS2}		—	—	2.0	μs
Peripheral Data Delay	t_{PDW}	Fig. 4	—	—	1.0	μs
Peripheral Data Setup Time for Latch	t_{PSU}	Fig. 9	100	—	—	ns
Peripheral Data Hold Time for Latch	t_{PDH}		15	—	—	ns

3. TIMER/COUNTER LINE TIMING

Item	Symbol	Test Condition	min	typ	max	Unit
$\overline{CTC}, \overline{CTG}$ Rise and Fall Time	t_{Cr}, t_{Cf}	Fig. 6	—	—	100	ns
$\overline{CTC}, \overline{CTG}$ Pulse Width, "High" (Asynchronous Mode)	t_{PWH}		$t_{cycE} + 250$	—	—	ns
$\overline{CTC}, \overline{CTG}$ Pulse Width, "Low" (Asynchronous Mode)	t_{PWL}		$t_{cycE} + 250$	—	—	ns
$\overline{CTC}, \overline{CTG}$ Setup Time (Synchronous Mode)	t_{su}	Fig. 7	200	—	—	ns
$\overline{CTC}, \overline{CTG}$ Hold Time (Synchronous Mode)	t_{hd}		50	—	—	ns
CTO Delay Time	t_{CTO}	Fig. 8	—	—	1.0	μs

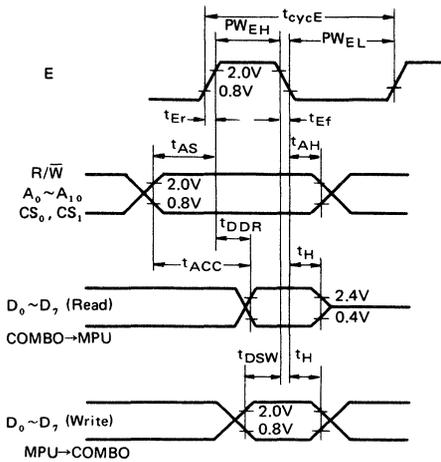


Figure 1 Bus Read/Write Timing

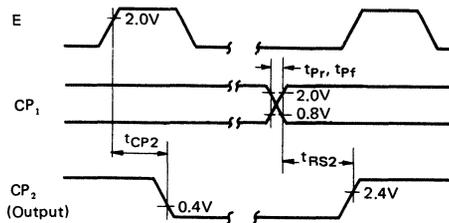


Figure 5 CP₂ (Output) Delay Time

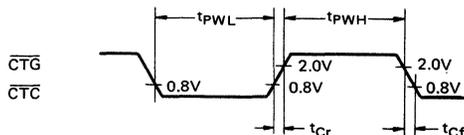


Figure 6 CTG, CTC Pulse Width

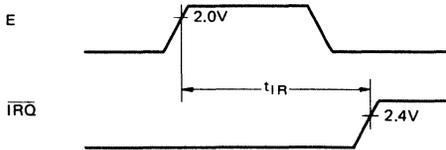


Figure 2 IRQ Release Time

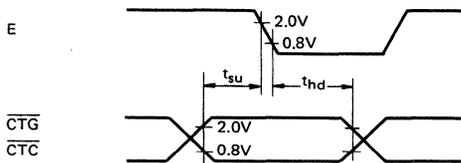


Figure 7 CTG, CTC Setup Time and Hold Time

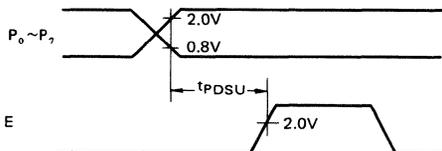


Figure 3 Peripheral Data Set Up Time

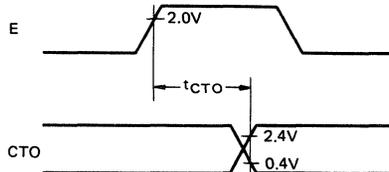


Figure 8 CTO Delay Time

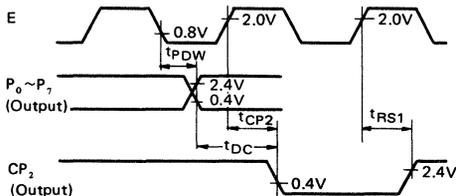


Figure 4 Peripheral Data and CP₂ (Output) Delay Time

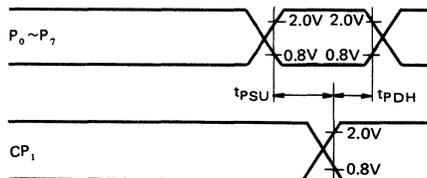


Figure 9 Peripheral Port Latch Setup and Hold Time

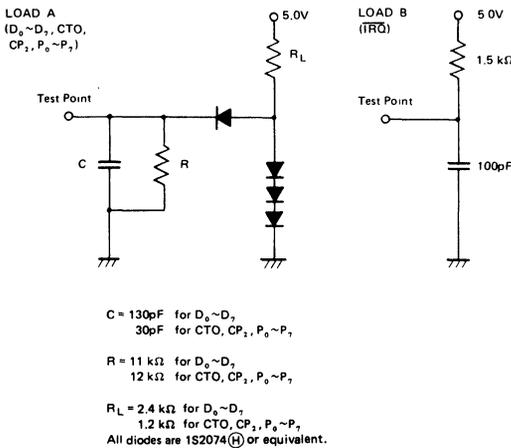


Figure 10 Bus Timing Test Loads

■ GENERAL DESCRIPTION

The HD6846 combination chip may be partitioned into three functional operating sections: programmed storage, timer-counter functions, and a parallel I/O port.

● Programmed Storage

The mask-programmable ROM section is similar to other ROM products of the HMCS6800 family. The ROM is organized in a 2048 by 8-bit array to provide read only storage for a minimum microcomputer system. Two mask-programmable chip selects are available for user definition.

Address inputs $A_0 \sim A_{10}$ allow any of the 2048 bytes of ROM to be uniquely addressed. Bidirectional data lines ($D_0 \sim D_7$) allow the transfer of data between the MPU and the HD 6846.

● Timer-Counter Functions

Under software control this 16-bit binary counter may be programmed to count events, measure frequencies, time intervals, or similar tasks. Internal registers associated with the I/O functions may be selected with A_0, A_1 and A_2 . It may also be used for square wave generation, single pulses of controlled duration, and gated signals. Interrupts may be generated from a number of conditions selectable by software programming.

The timer/counter control register allows control of the interrupt enable, output enable, selection of an internal or external clock source, a $\div 8$ prescaler, and operating mode. Input pin \overline{CTC} (counter-timer clock) will accept an asynchronous clock pulse to decrement the internal register for the counter-timer. If the divide-by-8 prescaler is used, the maximum clock rate can be four times the master clock frequency with an absolute maximum of 4 MHz. Gate input (\overline{CTG}) accepts an asynchronous TTL-compatible signal which may be used as a trigger or gating function to the counter-timer. A counter-timer output (CTO) is also available and is under software control being dependent on the timer control register, the gate input, and the clock source.

● Parallel I/O Port

The parallel bidirectional I/O port has functional operational characteristics similar to the B port on the HD6821 PIA. This includes 8 bidirectional data lines and two handshake control signals. The control and operation of these lines are completely software programmable.

The interrupt input (CP_1) will set the interrupt flag CSR1 of the composite status register. The peripheral control (CP_2) may be programmed to act as an interrupt input (set CSR2) or as a peripheral control output.

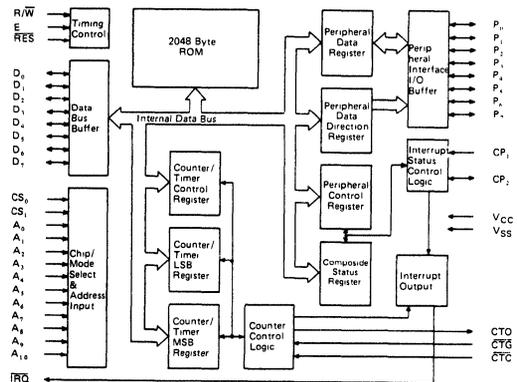


Figure 11 Combination ROM I/O Timer (COMBO) Basic Block Diagram

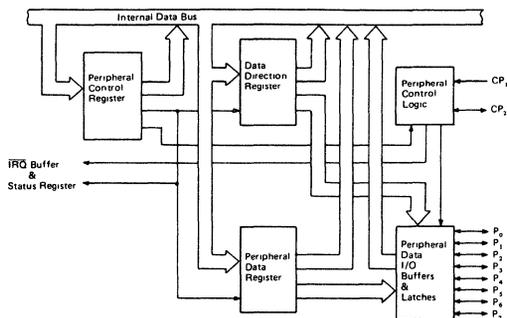


Figure 12 Parallel I/O Port Block Diagram

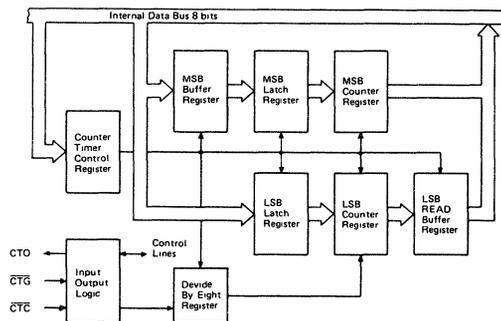


Figure 13 Timer/Counter Block Diagram

■ SIGNAL DESCRIPTION

● Bus Interface

The HD6846 interfaces to the HMCS6800 Bus via an eight bit bidirectional data bus, two Chip Select lines, a Read/Write line, and eleven address lines. These signals, in conjunction with the HMCS6800 VMA output, permit the MPU to control the HD6846.

● Bidirectional Data Bus (D₀ ~ D₇)

The bidirectional data lines (D₀ ~ D₇) allow the transfer of data between the MPU and the HD6846. The data bus output drivers are three-state devices which remain in the high-impedance (Off) state except when the MPU performs an HD6846 register or ROM read (R/ \bar{W} = 1 and I/O Registers or ROM selected).

● Chip Select (CS₀, CS₁)

The CS₀ and CS₁ inputs are used to select the ROM or I/O timer of the HD6846. They are mask programmed to be active "High" or active "Low" as chosen by the user.

● Address Inputs (A₀ ~ A₁₀)

The Address Inputs allow any of the 2048 bytes of ROM to be uniquely selected when the circuit is operating in the ROM mode. In the I/O-Timer mode, address inputs A₀, A₁, and A₂ select the proper I/O Register, while A₃ through A₁₀ (together with CS₀ and CS₁) can be used as additional qualifiers in the I/O Select circuitry. (See the section on I/O-Timer Select for additional details.)

● Reset (\bar{RES})

The active "Low" state of the \bar{RES} input is used to initialize all register bits in the I/O section of the device to their proper values. (See the section on Initialization for Reset conditions for timer and peripheral registers.)

● Enable (E)

This signal synchronizes data transfer between the MPU and the HD6846. It also performs an equivalent synchronization function on the external clock, reset, and gate inputs of the HD6846 Timer section.

● Read/Write (R/ \bar{W})

This signal is generated by the MPU and is used to control the direction of data transfer on the bidirectional data pins. A "Low" level on the R/ \bar{W} input enables the HD6846 input buffers and data is transferred to the circuit during the E pulse when the part has been selected. A "High" level on the R/ \bar{W} input enables the output buffers and data is transferred to the MPU during E when the part is selected.

● Interrupt Request (\bar{IRQ})

The active "Low" \bar{IRQ} output acts to interrupt the MPU through logic included on the HD6846. This output utilizes an open drain configuration and permits other interrupt request outputs from other circuits to be connected in a wire-OR configuration.

● Peripheral Data (P₀ ~ P₇)

The peripheral data lines can be individually programmed as either inputs or outputs via the Data Direction Register. When programmed as outputs, these lines will drive two standard TTL

loads (3.2 mA). They are also capable of sourcing up to 1.0 mA at 1.5 Volts (Logic "1" output.)

When programmed as inputs, the output drivers associated with these lines enter a three-state (high impedance) mode. Since there is no internal pull-up for these lines, they represent a maximum 10 μ A load to the circuitry driving them -- regardless of logic state.

A logic zero at the $\overline{\text{RES}}$ input forces the peripheral data lines to the input configuration by clearing the Data Direction Register. This allows the system designer to preclude the possibility of having a peripheral data output connected to an external driver output during power-up sequence.

• Interrupt Input (CP₁)

Peripheral input line CP₁ is an input-only that sets the Interrupt Flags of the Composite Status register. The active transition for this signal is programmed by the peripheral control register for the parallel port. CP₁ may also act as a strobe for the peripheral data register when it is used as an input latch. Details for programming CP₁ are in the section on the parallel peripheral port.

(Note)

Unexpected noise may occur on the peripheral data line when the peripheral data register is loaded with "1". This erroneous noise may occur only when peripheral data line is specified as output and the peripheral data register has already been loaded with "1". Note that peripheral data line doesn't keep "High" level continuously in the case write peripheral data register operation is executed.

• Peripheral Control (CP₂)

Peripheral Control line CP₂ may be programmed to act as an Interrupt input or Peripheral Control output. As an input, this line has high impedance and is compatible with standard TTL voltage levels. As an output, it is also TTL compatible and may be used as a source of 1 mA at 1.5 V to directly drive the base of a Darlington transistor switch. This line is programmed by the Peripheral Control Register.

• Counter Timer Output (CTO)

The Counter Timer Output is software programmable by selected bits in the timer/counter control register. The mode of operation is dependent on the Timer control register, the gate input, and the clock source. The output is TTL compatible.

• External Clock Input ($\overline{\text{CTC}}$)

Input pin $\overline{\text{CTC}}$ will accept asynchronous TTL voltage level signals to be used as a clock to decrement the Timer. The "High" and "Low" levels of the external clock must be stable for at least one system clock period plus the sum of the setup and hold times for the inputs. The asynchronous clock rate can vary from dc to the limit imposed by System E, setup, and hold times.

The external clock input is clocked in by Enable pulses. Three Enable periods are used to synchronize and process the

external clock. The fourth Enable pulse decrements the internal counter. This does not affect the input frequency; it merely creates a delay between a clock input transition and internal recognition of that transition by the HD6846. All references to $\overline{\text{CTC}}$ inputs in this document relate to internal recognition of the input transition. Note that a clock transition which does not meet setup and hold time specifications may require an additional Enable pulse for recognition.

When observing recurring events, a lack of synchronization will result in either "System jitter" or "Input jitter" being observed on the output of the HD6846 when using an asynchronous clock and gate input signal. "System jitter" is the result of the input signals being out of synchronization with Enable, permitting signals with marginal set-up and hold time to be recognized by either the bit time nearest the input transition or subsequent bit time. "Input jitter" can be as great as the time between the negative going transitions of the input signal plus the system jitter if the first transition is recognized during one system cycle, and not recognized the next cycle or vice-versa.

• Gate Inputs ($\overline{\text{CTG}}$)

The input pin $\overline{\text{CTG}}$ accepts an asynchronous TTL-compatible signal which is used as a trigger or a clock gating function to the Timer. The gating input is clocked into the HD6846 by the Enable signal in the same manner as the previously discussed clock inputs. That is, a $\overline{\text{CTG}}$ transition is recognized on the fourth Enable pulse (provided setup and hold time requirements are met), and the "High" or "Low" levels of the $\overline{\text{CTG}}$ input must be stable for at least one system clock period plus the sum of setup and hold times. All references to $\overline{\text{CTG}}$ transition in this document relate to internal recognition of the input transition.

The $\overline{\text{CTG}}$ input of the timer directly affects the internal 16-bit counter. The operation of $\overline{\text{CTG}}$ is therefore independent of the $\div 8$ prescaler selection.

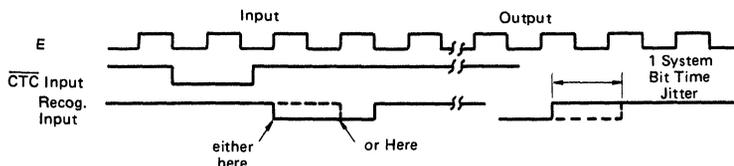
■ FUNCTIONAL SELECT CIRCUITRY

• I/O-Timer Select Circuitry

CS₀ and CS₁ are user programmable. Any of the four binary combinations of CS₀ and CS₁ can be used to select the ROM. Likewise, any other combination can be used to select the I/O-Timer. In addition, several address lines are used as qualifiers for the I/O-Timer. Specifically, A₃ = A₄ = A₅ = logical "0". A₆ can be programmed to a "1", "0", or don't care. A₇ = A₈ = A₉ = A₁₀ = don't care or one line only may be programmed to a logical "1". Figure 14 outlines in diagrammatic form the available chip select options.

• Internal Addressing

Seven I/O Register locations within the HD6846 are accessible to the MPU data bus. Selection of these registers is controlled by A₀, A₁, and A₂ (as shown in Table 1) provided the I/O timer is selected. The combination status register is Read-only; all other Registers are Read and Write.



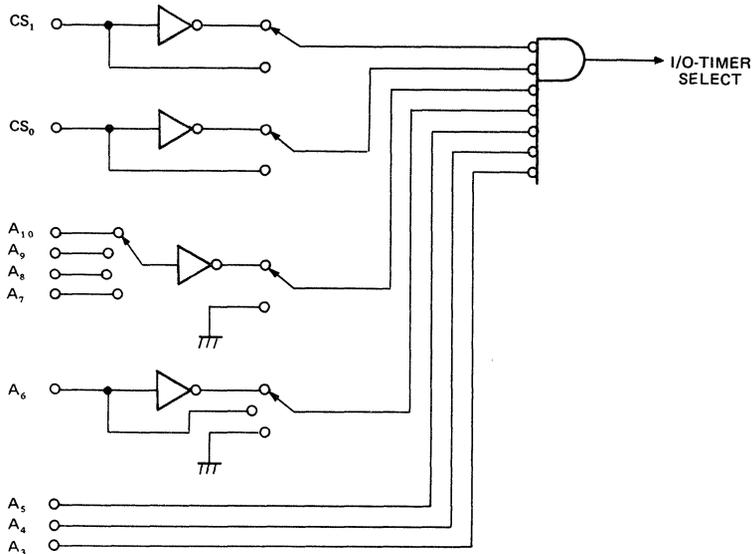


Figure 14 I/O-Timer Select Circuitry

Table 1 Internal Register Addresses

REGISTER SELECTED	A ₂	A ₁	A ₀
Combination Status Register	0	0	0
Peripheral Control Register	0	0	1
Data Direction Register	0	1	0
Peripheral Data Register	0	1	1
Combination Status Register	1	0	0
Timer Control Register	1	0	1
Timer MSB Register	1	1	0
Timer LSB Register	1	1	1
ROM Address	x	x	x

Initialization

When the \overline{RES} input has accepted a "Low" signal, all registers are initialized to the reset state. The data direction and peripheral data registers are cleared. The Peripheral Control Register is cleared except for bit 7 (the \overline{RES} bit). This forces the parallel port to the input mode with Interrupts disabled. To remove the \overline{RES} condition from the parallel port, a "0" must be written into the Peripheral Control Register bit 7 (PCR7).

The counter latches are preset to their maximal count, the Timer control register bits are reset to zero except for Bit 0 (TCR0 is set), the counter output is cleared, and the counter clock disabled. This state forces the timer counter to remain in an inactive state. The combination status register is cleared of all interrupt flags. During timer initialization, the reset bit (CCRO) must be cleared.

ROM

The Mask Programmable ROM section is similar in operation to other ROM products of the HMCS6800 Microprocessor family. The ROM is organized as 2048 words of 8-bits to provide read-only storage for a minimum microcomputer system. The ROM is active when selected by the unique

combination of the chip select inputs.

ROM Select

The active levels of CS₀ and CS₁ for ROM and I/O select are a user programmable option. Either CS₀ or CS₁ may be programmed active "High" or active "Low", but different codes must be used for ROM or I/O select. CS₀ and CS₁ are mask programmed simultaneously with the ROM pattern. The ROM Select Circuitry is shown in Figure 15.

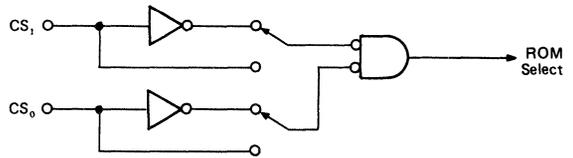


Figure 15 ROM Select Circuitry

■ TIMER OPERATION

The Timer may be programmed to operate in modes which fit a wide variety of applications. The device is fully bus compatible with the HMCS6800 system, and is accessed by Load and Store operations from the MPU.

In a typical application, the timer will be loaded by storing two bytes of data into the counter latch. This data is then transferred into the counter during a Counter Initialization cycle. The counter decrements on each subsequent clock cycle (which may be Enable or an external clock) until one of several predetermined conditions causes it to halt or recycle. Thus the timer is programmable, cyclic in nature, controllable by external inputs or MPU program, and accessible to the MPU at any time.

● Counter Latch Initialization

The Timer consists of a 16-bit addressable counter and two 8-bit addressable latches. The function of the latches is to store a binary equivalent of the desired count value minus one. Counter initialization results in the transfer of the latch contents of the counter. It should be noted that data transfer to the counters is always accomplished via the latches. Thus, the counter latches may be accurately described as a 16-bit "counter initialization data" storage register.

In some modes of operation, the initialization of the latches will cause simultaneous counter initialization (i.e. immediate transfer of the new latch data into the counters). It is, therefore, necessary to insure that all-16-bit of the latches are updated simultaneously. Since the HD6846 data bus is 8-bit wide, a temporary register (MSB Buffer Register) is provided for in the Most Significant Byte of the desired latch data. This is a "write-only" register selected via address lines A_0 , A_1 , and A_2 . Data is transferred directly from the data bus to the MSB Buffer when the chip is selected, R/\bar{W} is "Low", and the timer MSB register is selected ($A_0 = "0"$, $A_1 = A_2 = "1"$).

The lower 8-bit of the counter latch can also be referred to as a "write-only" register. Data Bus information will be transferred directly to the LSB of a counter latch when the chip is selected, R/\bar{W} is "Low" and the Timer LSB Register is selected ($A_0 = A_1 = A_2 = "1"$). Data from the MSB Buffer will automatically be transferred into the Most Significant Byte of the counter latches simultaneously with the transfer of the Data Bus information to the Least Significant Byte of the Counter Latch. For brevity, the conditions for this operation will be referred to henceforth as a "Write Timer Latches Command."

The HD6846 has been designed to allow transfer of two bytes of data into the counter latches from any source, provided the MSB is transferred first. In many applications, the source of data will be an HMCS6800 MPU. It should therefore be noted that the 16-bit store operations of the HMCS6800 family microprocessors (STS and STX) transfer data in the order required by the HD6846. A Store Index Register instruction, for example, results in the MSB of the index register being transferred to the selected address, then the LSB of the index register being written into the next higher location. Thus, either

the index register or stack pointer may be transferred directly into a selected counter latch with a single instruction.

A logic zero at the RES input also initializes the counter latches. All latches will assume maximum count (65,535) values. It is important to note that an internal reset (Bit zero of the Timer/Control Register Set) has no effect on the counter latches.

● Counter Initialization

Counter Initialization is defined as the transfer of data from the latches to the counter with attendant clearing of the Individual Interrupt Flag associated with the counter. Counter Initialization always occurs when a reset condition (external RES = "0" or TCRO = "1") is recognized. It can also occur (dependent on The Timer Mode) with a Write Timer Latches command or recognition of a negative transition of the CTG input.

Counter recycling or reinitialization occurs when a clock input is recognized after the counter has reached an all-zero state. In this case, data is transferred from the Latches to the Counter, but the Interrupt Flag is unaffected.

● Timer Control Register

The Timer Control register (see Table 2) in the HD6846 is used to modify timer operation to suit a variety of applications. The Timer Control Register has a unique address space ($A_0 = "1"$, $A_1 = "0"$, $A_2 = "1"$) and therefore may be written into at any time. The least significant bit of the Control Register is used as an Internal Reset bit. When this bit is a logic zero, all timers are allowed to operate in the modes prescribed by the remaining bits of the timer control register.

Writing "1" into Timer Control Register Bit 0 (TCRO) causes the counter to be preset with the contents of the counter latches, all counter clocks are disabled, and the timer output and interrupt flag (Status Register) are reset. The Counter Latch and Timer/Control Register are undisturbed by an Internal Reset and may be written into regardless of the state of TCRO.

Timer Control Register Bit 1 (TCR1) is used to select the clock source. When TCR1 = "0", the external clock input CTC is selected, and when TCR1 = "1", the timer uses Enable.

Table 2 Format for Timer/Counter Control Register

CONTROL REGISTER BIT	STATE	BIT DEFINITION	STATE DEFINITION
TCRO	0	Internal Reset	Timer Enabled
	1		Timer in Preset State
TCR1	0	Clock Source	Timer uses External Clock (CTC)
	1		Timer uses $\phi 2$ System Clock
TCR2	0	$\div 8$ Prescaler Enabler	Clock is not Prescaled
	1		Clock is prescaled by $\div 8$ Counter
TCR3 TCR4 TCR5	\times \times \times	Operating Mode Selection	See Table 3
TCR6	0	Timer Interrupt Enable	$\bar{I}RQ$ Masked from Timer
	1		$\bar{I}RQ$ Enabled from Timer
TCR7	0	Timer Output Enable	Counter Output (CTO) Set "Low"
	1		Counter Output Enabled

Table 3 Counter/Timer Operation Modes

Mode	TCR3	TCR4	TCR5	Counter Initialization	Counter Enable	Counter Clock "CC"	Interrupt Flag	
							Set	Clear
Continuous Mode	0	0	0	$\overline{G} \downarrow + W + R$	$(\overline{G} = \text{Low}) \cdot \overline{R}$	$CE \cdot C$	TO	RS-RT or CI
	0	1	0	$\overline{G} \downarrow + R$	$(\overline{G} = \text{Low}) \cdot \overline{R}$	$CE \cdot C$	TO	RS-RT or CI
Cascaded Single Shot Mode	0	0	1	$\overline{G} \downarrow + W + R$	\overline{R}	$CE \cdot C$	TO	RS-RT or CI
Normal Single Shot Mode	0	1	1	$\overline{G} \downarrow + R$	\overline{R}	$CE \cdot C$	TO	RS-RT or CI
Frequency Comparison Mode	1	0	0	$(\overline{CE} + \text{TOF} \cdot \overline{CE}) \cdot \overline{G} \downarrow + R$	CE set = $\overline{G} \downarrow \cdot \overline{W} \cdot \overline{R} \cdot \overline{T}$ CE reset = $W + R + I$	$CE \cdot C$	$\overline{G} \downarrow$ before TO	RS-RT or CI or W
	1	0	1	$\overline{G} \downarrow \cdot \overline{T} + R$	CE set = $\overline{G} \downarrow \cdot \overline{W} \cdot \overline{R} \cdot \overline{T}$ CE reset = $W + R + I$	$CE \cdot C$	$\overline{G} \downarrow$ before TO	RS-RT or CI or W
Pulse Width Comparison Mode	1	1	0	$\overline{G} \downarrow \cdot \overline{T} + R$	CE set = $\overline{G} \downarrow \cdot \overline{W} \cdot \overline{R} \cdot \overline{T} \cdot \overline{G}$ CE reset = $W + R + I + (\overline{G} = \text{High})$	$CE \cdot C$	$\overline{G} \uparrow$ before TO	RS-RT or CI or W
	1	1	1	$\overline{G} \downarrow \cdot \overline{T} + R$	CE set = $\overline{G} \downarrow \cdot \overline{W} \cdot \overline{R} \cdot \overline{T} \cdot \overline{G}$ CE reset = $W + R + I + (\overline{G} = \text{High})$	$CE \cdot C$	$\overline{G} \uparrow$ before TO	RS-RT or CI or W

R = External \overline{RES} or Internal Reset TCR0
 W = Write Timer Latch
 I = Interrupt Flag
 \overline{G} = CTG
 C = Clock selected in the internal register
 $\overline{G} \downarrow$ = Negative transition of CTG signal
 $\overline{G} \uparrow$ = Positive transition of CTG signal
 RS-RT = Read Operation of Timer Counter after the read of Status Register (Normal operation to clear the interrupt)
 CI = Counter Initialization (Internal Signal)
 TOF = Time Out Flag (Set by \overline{CI} -TO, Reset by CI)

TO = Counter Time Out

Timer Control Register Bit 2 (TCR2) enables the ÷ 8 prescaler (TCR2 = "1"). In this mode, the clock frequency is divided by eight before being applied to the counter. When TCR2 = "0" Enable is applied directly to the counter.

TCR3, 4, 5 select the Timer Operating Mode, and are discussed in the next section.

Timer Control Register Bit 6 (TCR6) is used to mask or enable the Timer Interrupt Request. When TCR6 = "0", the Interrupt Flag is masked from the timer. When TCR6 = "1", the Interrupt Flag is enabled into Bit 7 of the Composite Status Register (Composite IRQ Bit), which appears on the IRQ output pin.

Timer Control Register Bit Seven (TCR7) has a special function when the timer is in the Cascaded Single Shot mode. (This function is explained in detail in the section describing the mode.) In all other modes, TCR7 merely acts as an output enable bit. If TCR7 = "0", the Counter Timer Output (CTO) is forced "Low". Writing a logic one into TCR7 enables CTO.

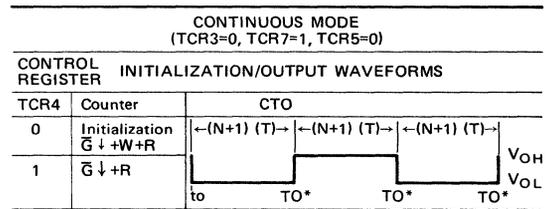
• Timer Operating Modes

The HD6846 has been designed to operate effectively in a wide variety of applications. This is accomplished by using three bits of the control register (TCR3, TCR4, and TCR5) to define different operating modes of the Timer, outlined in Table 3.

• Continuous Operating Mode (TCR3 = 0, TCR5 = 0)

The timer may be programmed to operate in a continuous counting mode by writing zeros into bits 3 and 5 of the timer control register. Assuming that the timer output is enabled (TCR7 = "1"), a square wave will be generated at the Timer Output CTO (See Table 4).

Table 4 Continuous Operating Modes



$\overline{G} \downarrow$ = Negative Transition CTG Input.
 W = Write Timer Latches Command.
 R = Timer Reset (TCR0=1 or External \overline{RES} =0)
 N = 16 Bit Number in Counter Latch.
 T = Period of Clock Input to Counter.
 to = Counter Initialization Cycle.
 TO = Counter Time Out (All Zero Condition.)
 * Point at which an interrupt may occur.

Either a Timer Reset (TCR0 = "1" or External \overline{RES} = "0") condition or internal recognition of a negative transition of the CTG input results in Counter Initialization. A Write Timer Latches command can be selected as a Counter Initialization signal by clearing TCR4.

The discussion of the Continuous Mode has assumed the application requires an output signal. It should be noted the Timer operates in the same manner with the output disabled (TCR7 = "0"). A Read Timer Counter command is valid regardless of the state of TCR7.

● **Normal Single-Shot Timer Mode (TCR3 = 0, TCR4 = 1, TCR5 = 1)**

This mode is identical to the Continuous Mode with two exceptions. The first of these is obvious from the name – the output returns to a “Low” level after the initial Time Out and remains “Low” until another Counter Initialization cycle occurs. The output waveform (CTO) is shown in Figure 16.

As indicated in Figure 16, the internal counting mechanism remains cyclical in the Single-Shot Mode. Each Time Out of the counter results in the setting of an Individual Interrupt Flag and re-initialization of the counter.

The second major difference between the Single-Shot and Continuous modes is that the internal counter enable is not dependent on the \overline{CTG} input level remaining in the “Low” state for the Single-Shot mode. Aside from these differences, the two modes are identical.

● **Cascaded Single-shot Mode (TCR3=0, TCR4=0, TCR5=1)**

This mode is identical to the single-shot mode with two exceptions. First, the output waveform does not return to a “Low” level and remain “Low” after timeout. Instead, the output level remains at its initialized level until it is re-programmed and changed by timeout. The output level may be changed at any timeout or may have any number of timeouts between changes.

The second difference is the method used to change the output level. Timer Control Register Bit 7 (TCR7) has a special function in this mode. The timer output (CTO) is equal to TCR7 clocked by timeout. At every timeout, the content of TCR7 is clocked to and held at the CTO output. Thus, output pulses of length greater than one timer cycle can be generated by cascading timer cycles and counting timeouts with a software program (See Figure 16).

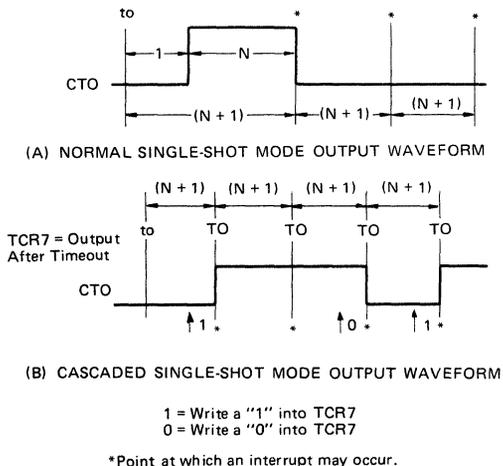
An interrupt is generated at each timeout. To cascade timer cycles, the MPU would need an interrupt routine to: 1) count each timeout and determine when to change TCR7; 2) write into TCR7 the state corresponding to the next desired state of the output waveform (only necessary during the last timer cycle before the output is to change state); and 3) clear the interrupt flag by reading the combination status register followed by Read Timer MSB. It is also possible, if desired, to change the length of the timer cycle by reinitializing the timer latches. This allows more flexibility for obtaining desired times.

● **Time Interval Modes (TCR3 = 1)**

The Time Interval Modes are provided for applications requiring more flexibility of interrupt generation and Counter Initialization. The Interrupt Flag is set in these modes as a function of both Counter Time Out and transitions of the \overline{CTG} input. Counter Initialization is also affected by Interrupt Flag status. The output signal is not defined in any of these modes. Other features of the Time Interval Modes are Outlined in Table 5.

● **Frequency Comparison Mode (TCR3 = 1, TCR4 = 0)**

The timer within the HD6846 may be programmed to compare the period of a pulse (giving the frequency after calculations) at the \overline{CTG} input with the time period required for Counter Time Out. A negative transition of the \overline{CTG} input enables the counter and starts a Counter Initialization cycle – provided that other conditions as noted in Table 3 are satisfied. The counter decrements on each clock signal recognized during or after Counter Initialization until an Interrupt is generated, a



(NOTE) All time intervals shown above assume the Gate (\overline{CTG}) and Clock (\overline{CTC}) signals are synchronized to Enable with the specified setup and hold time requirements.

Figure 16 Single-Shot Modes

Table 5 Time Interval Modes

TCR3 = 1			
TCR4	TCR5	APPLICATION	CONDITION FOR SETTING INDIVIDUAL INTERRUPT FLAG
0	0	Frequency Comparison	Interrupt Generated if \overline{CTG} Input Period (1/F) is Less Than Counter Time Out (TO).
0	1	Frequency Comparison	Interrupt Generated if \overline{CTG} Input Period (1/F) is Greater Than Counter Time Out (TO).
1	0	Pulse Width Comparison	Interrupt Generated if \overline{CTG} Input “Down Time” is Less Than Counter Time Out (TO).
1	1	Pulse Width Comparison	Interrupt Generated if \overline{CTG} Input “Down Time” is Greater Than Counter Time Out (TO).

Write Timer Latches command is issued, or a Timer Reset condition occurs. It can be seen from Table 3 that an interrupt condition will be generated if $TCR5 = "0"$ and the period of the pulse (single pulse or measured separately repetitive pulses) at the \overline{CTG} input is less than the Counter Time Out period. If $TCR5 = "1"$, an interrupt is generated if the reverse is true.

Assume now with $TCR5 = "1"$ that a Counter Initialization has occurred and that the \overline{CTG} input has returned "Low" prior to Counter Time Out. Since there is no Individual Interrupt Flag generated, this automatically starts a new Counter Initialization Cycle. The process will continue with frequency comparison being performed on each \overline{CTG} input cycle until the mode is changed, or a cycle is determined to be above the predetermined limit.

● **Pulse Width Comparison Mode ($TCR3 = 1, TCR4 = 1$)**

This mode is similar to the Frequency Comparison Mode except for the limiting factor being a positive, rather than negative, transition of the \overline{CTG} input. With $TCR5 = "0"$, an Individual Interrupt Flag will be generated if the zero level pulse applied to the \overline{CTG} input is less than the time period required for Counter Time Out. With $TCR5 = "1"$, the interrupt is generated when the reverse condition is true.

As can be seen in Table 3, a positive transition of the \overline{CTG} input disables the counter. With $TCR5 = "0"$, it is therefore possible to directly obtain the width of any pulse causing an interrupt.

● **Composite Status Register**

The Composite Status Register (CSR) is a read-only register which is shared by the Timer and the Peripheral Data Port of the HD6846. Three individual interrupt flags in the register are set directly via the appropriate conditions in the timer or peripheral port. The composite interrupt flag – and the \overline{IRQ} Output – respond to these individual interrupts only if corresponding enable bits are set in the appropriate Control Registers. (See Figure 17.) The sequence of assertion is not detected. Setting $TCR6$ while $CSR0$ is "High" will cause $CSR7$ to be set, for example.

The Composite Interrupt Flag ($CSR7$) is clear only if all enabled Individual Interrupt Flags are clear. The conditions for

clearing $CSR1$ and $CSR2$ are detailed in a later section. The Timer Interrupt Flag ($CSR0$) is cleared under the following conditions:

- 1) Timer Reset – Internal Reset Bit ($TCR0$) = "1" or External $\overline{RES} = "0"$.
- 2) Any Counter Initialization condition.
- 3) A Write Timer Latches command if Time Interval modes ($TCR3 = "1"$) are being used.
- 4) A Read Timer Counter command, provided this is preceded by a Read Composite Status Register while $CSR0$ is set. This latter condition prevents missing an Interrupt Request generated after reading the Status Register and prior to reading the counter.

The remaining bits of the Composite Status Register ($CSR3 \sim CSR6$) are unused. They default to a logic zero when read.

■ **I/O OPERATION**

● **Parallel Peripheral Port**

The peripheral port of the HD6846 contains 8 Peripheral Data lines ($P_0 \sim P_7$), two Peripheral Control lines (CP_1 and CP_2), a Data Direction Register, a Peripheral Data Register, and a Peripheral Control Register. The port also directly affects two bits ($CSR1$ and $CSR2$) of the Composite Status Register.

The Peripheral Port is similar to the "B" side of a PIA (HD6821) with the following exceptions:

- 1) All registers are directly accessible in the HD6846. Data Direction and Peripheral Data in the HD6821 are located at the same address with Bit Two of the Control Register used for register selection.
- 2) Peripheral Control Register Bit Two ($PCR2$) of the HD6846 is used to select an optional input latch function. This option is not available with HD6821 PIA's.
- 3) Interrupt Flags are located in the HD6846 composite status register rather than Bits 6 and 7 of the Control Register as used in the HD6821.
- 4) Interrupt Flags are cleared in the HD6821 by reading data from the Peripheral Data Register. HD6846 Interrupt Flags are cleared by either reading or writing to the Peripheral Data Register – provided that this sequence is followed a) Flag Set, b) Read Composite Status Register, c) Read/Write Peripheral Data Register is followed.

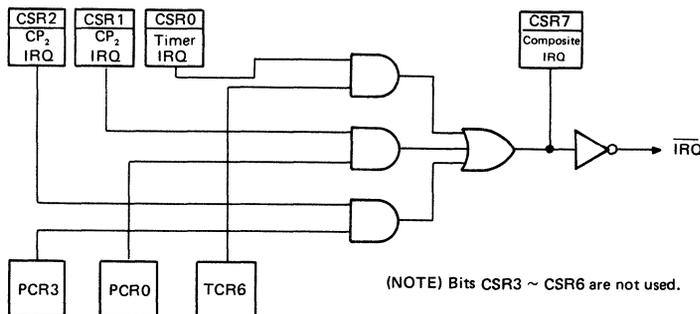


Figure 17 Composite Status Register & Associated Logic

- 5) Bit 6 of the HD6846 Peripheral Control Register is not used. Bit 7 (PCR7) is an Internal Reset Bit not available on the HD6821.
- 6) The Peripheral Data lines (and CP₂) of the HD6846 feature internal current limiting which allows them to directly drive the base of Darlington NPN transistors.

• **Data Direction Register**

The MPU can write directly to this eight-bit register to configure the Peripheral Data lines as either inputs or outputs. A particular bit within the register (DDRn) is used to control the corresponding Peripheral Data line (Pn). With DDRn = "0", Pn becomes an input; if DDRn = "1", Pn is an output. As an example, writing Hex \$0F into the Data Direction Register results in P₀ thru P₃ becoming outputs and P₄ thru P₇ being inputs. Hex \$55 in the Data Direction Register results in alternate outputs and inputs at the parallel port.

• **Peripheral Data Register**

This eight-bit register is used for transferring data between the peripheral data port and the MPU. Any bit corresponding to an output line will be used to drive the output buffer associated with that line. Data in these output bits is normally provided by an MPU Write function. (Input bits – those associated with input lines – are unchanged by a Write Command.) Any input bit will reflect the state of the associated input line if the input latch function is deselected. If the Control Register is programmed to provide input latching, the input bit will retain the state at the time CP₁ was activated until the Peripheral Data Register is read by the MPU.

• **Peripheral Control Register**

This eight-bit register is used to control the reset function as well as for selection of optional functions of the two peripheral control lines (CP₁ and CP₂). The Peripheral Control Register functions are outlined in Table 6.

• **Peripheral Port Reset (PCR7)**

Bit 7 of the Peripheral Control Register (PCR7) may be used to initialize the peripheral section of the HD6846. When this bit is set "High", the peripheral data register, the peripheral data direction register, and the interrupt flags associated with the peripheral port (CSR1 & CSR2) are all cleared. Other bits in the peripheral control register are not affected by PCR7.

PCR7 is set by either a logic zero at the External RES input or under program control by writing a "1" into the location. In any case, PCR7 may be cleared only by writing a zero into the location while RES is "High". The bit must be cleared to activate the port.

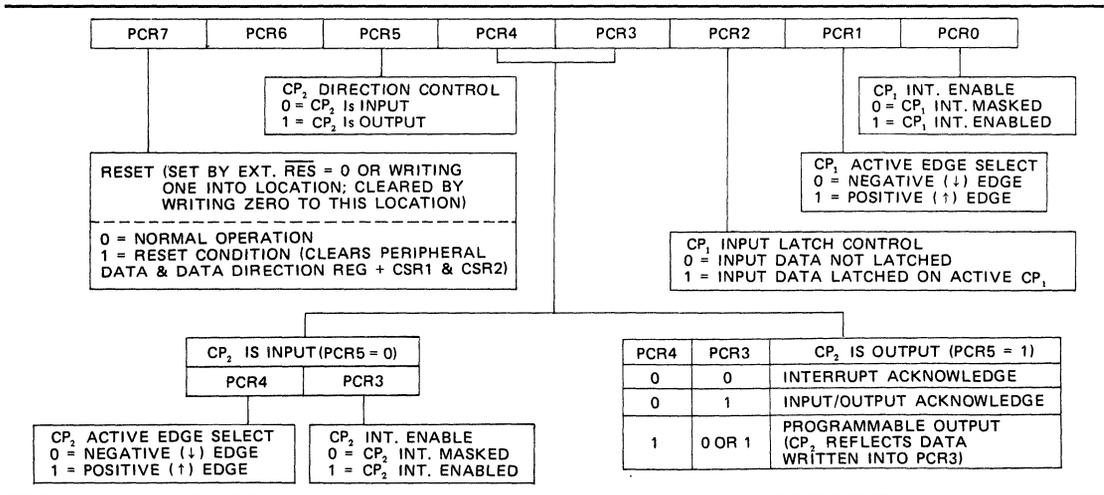
• **Control of CP₁ Peripheral Control Line**

CP₁ may be used an interrupt request to the HD6846, as a strobe to allow latching of input data, or both. In any case, the input can be programmed to be activated by either a positive or negative transition of the signal. These options are selected via Control Register Bits PCR0, RCR1 & PCR2.

Control Register Bit 0 (PCR0) is used to enable the interrupt transfer circuitry of the HD6846. Regardless of the state of PCR0, and active transition of CP₁ causes the Composite Status Register Bit One (CSR1) to be set. if PCR0 = "1", this interrupt will be reflected in the Composite Interrupt Flag (CSR7), and thus at the TRQ output. CSR1 is cleared by a Peripheral Port Reset condition or by either reading or writing to the peripheral data register after the Composite Status Register is read. The latter alternative is conditional – CSR1 must have been a logic one when the Composite Status Register was last read. This precludes inadvertent clearing of interrupt flags generated between the time the Status Register is read and the manipulation of peripheral data.

Control Register Bit One (PCR1) is used to select the edge which activates CP₁. When PCR1 = "0", CP₁ is active on negative transitions ("High" to "Low"). "Low" to "High" transitions are sensed by CP₁ when PCR1 = "1".

Table 6 Peripheral Control Register Format (Expanded)



In addition to its use as an interrupt input, CP₁ can be used as a strobe to capture input data in an internal latch. This option is selected by writing a one into Peripheral Control Register Bit Two (PCR2). In operating, the data at the pins designated by the Data Direction Register as inputs will be captured by an active transition of CP₁. An MPU Read of the Peripheral Data Register will result in the captured data being transferred to the MPU – and it also releases the latch to allow capture of new data. Note that successive active transitions with no Read Peripheral Data Command between does not update the input latch. Also, it should be noted that use of the input latch function (which can be deselected by writing a zero into PCR2) has no effect on output data. It also does not affect Interrupt function of CP₁.

• **Control of CP₂ Peripheral Control Line**

CP₂ may be used as an input by writing a zero into PCR5. In this configuration, CP₂ becomes a dual of CP₁ in regard to generation of interrupts. An active transition (as selected by PCR4) causes Bit Two of the Composite Status Register to be set. PCR3 is then used to select whether the CP₂ transition is to cause CSR7 to be set – and thereby cause IRQ to go “Low”. CP₂ has no effect on the input latch function of the HD6846.

Writing a one into PCR5 causes CP₂ to function as an output. PCR4 then determines whether CP₂ is to be used in a handshake or programmable output mode. With PCR4 = “1”, CP₂ will merely reflect the data written into PCR3. Since this can readily be changed under program control, this mode allows CP₂ to be a programmable output line in much the same

manner as those lines selected as outputs by the Data Direction Register.

The handshaking mode (PCR5 = “1”, PCR4 = “0”) allows CP₂ to perform one of two functions as selected by PCR3. With PCR3 = “1”, CP₂ will go “Low” on the first Enable positive transition after a Read or Write to the Peripheral Data Register. This Input/Output Acknowledge signal is released (returns “High”) on the next positive transition of the Enable signal.

In the Interrupt Acknowledge mode (PCR5 = “1”, PCR4 = PCR3 = “0”), CP₂ is set when CSR1 is set by an active transition of CP₁. It is released (goes “Low”) on the first positive transition of Enable after CSR1 has been cleared via an MPU Read or Write to the Peripheral Data Register. (Note that the previously described conditions for clearing CSR1 still apply.)

• **Restart Sequence**

A typical restart sequence for the HD6846 will include initialization of both the Peripheral Control & Data Direction Registers of the parallel port. It is necessary to set up the Peripheral Control Register first, since PCR7 = “0” is a condition for writing data into the Data Direction Register. (A logic zero at the external RES input automatically sets PCR7.)

• **Summary**

The HD6846 has several optional modes of operation which allow it to be used in a variety of applications. The following tables are provided for reference in selecting these modes.

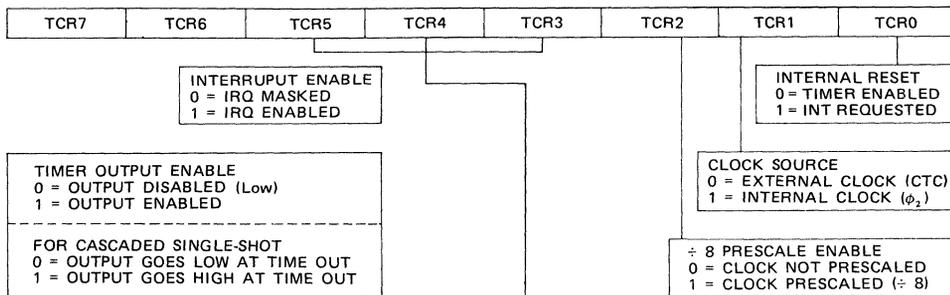
Table 7 HD6846 Internal Register Addresses

R/W	A ₂	A ₁	A ₀	REGISTER SELECTED
R	0	0	0	Combination Status Register
R/W	0	0	1	Peripheral Control Register
R/W	0	1	0	Data Direction Register
R/W	0	1	1	Peripheral Data Register
R	1	0	0	Combination Status Register
R/W	1	0	1	Timer Control Register
R/W	1	1	0	Timer MSB Register
R/W	1	1	1	Timer LSB Register
R	x	x	x	ROM Address

Table 8 Composite Status Register

CSR7	CSR3~CSR6 NOT USED DEFAULT TO ZERO WHEN READ	CSR2	CSR1	CSR0
COMPOSITE INTERRUPT FLAG 0 = NO ENABLED INTERRUPT FLAG SET 1 = ONE OR MORE ENABLED INTERRUPT FLAGS SET* INVERSE OF THIS BIT APPEARS AT IRQ OUTPUT *STATUS OF THIS BIT CAN BE EXPRESSED AS: CSR7 = CSR0·TCR6 + CSR1·PCR0 + CSR2·PCR3		CP ₁ INTERRUPT FLAG 0 = NO INT REQ 1 = INT REQUESTED	TIMER INTERRUPT FLAG 0 = NO INT REQ. 1 = INT REQUESTED CP ₁ INTERRUPT FLAG 0 = NO INT REQ. 1 = INT REQUESTED	

Table 9 Timer Control Register

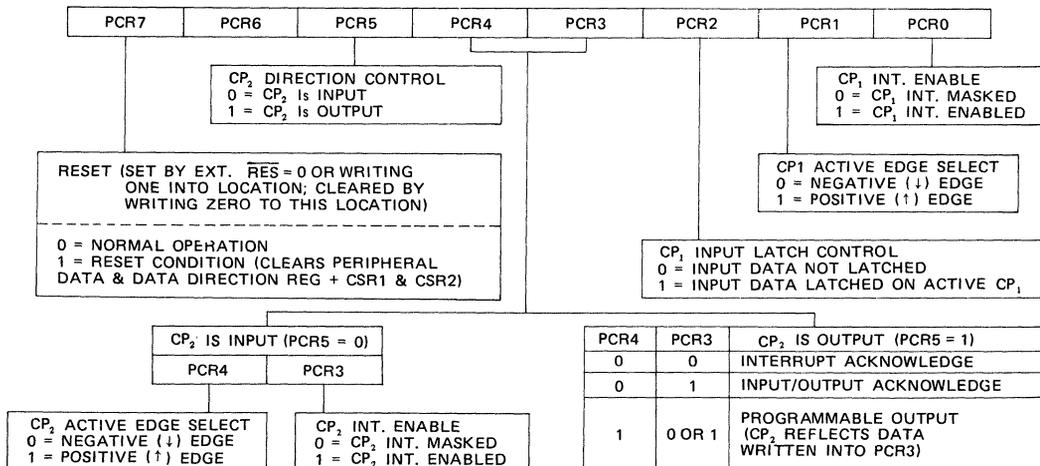


TCR3	TCR4	TCR5	TIME OPERATING MODE	COUNTER INITIALIZATION	INTERRUPT FLAG SET
0	0	0	CONTINUOUS	$\overline{CTG} \downarrow + W + R$	TO
0	0	1	CASCADED SINGLE SHOT	$\overline{CTG} \downarrow + W + R$	TO
0	1	0	CONTINUOUS	$\overline{CTG} \downarrow + R$	TO
0	1	1	NORMAL SINGLE SHOT	$\overline{CTG} \downarrow + R$	TO
1	0	0	FREQUENCY COMPARISON	$\overline{CTG} \downarrow \cdot \overline{T} \cdot (CE + TOF \cdot CE) + R$	CTG \downarrow BEFORE TO
1	0	1		$\overline{CTG} \downarrow \cdot \overline{T} + R$	TO BEFORE CTG
1	1	0	PULSE WIDTH COMPARISON	$\overline{CTG} \downarrow \cdot \overline{T} + R$	CTG \uparrow BEFORE TO
1	1	1		$\overline{CTG} \downarrow \cdot \overline{T} + R$	TO BEFORE CTG \uparrow

R = RESET CONDITION
 W = WRITE TIMER LATCHES
 TO = COUNTER TIME OUT
 CE = COUNTER ENABLE

$\overline{CTG} \downarrow$ = NEG TRANSITION OF PIN 17
 $\overline{CTG} \uparrow$ = POS TRANSITION OF PIN 17
 \overline{T} = INTERRUPT FLAG (CSR0) = 0

Table 10 Peripheral Control Register



■ CUSTOM PROGRAMMING

By the programming of a single photomask for the HD6846, the customer may specify the content of the memory and the method of enabling the outputs.

Information on the general options of the HD6846 should be submitted on an Organizational Data form such as that

shown in Figure 18 and Figure 19.

Information for custom memory content may be sent to HITACHI in one of two forms (shown in order of preference):

- 1) Paper tape output of the HMCS6800 Load Module Format or of the BNP Format
- 2) Hexadecimal coding using IBM Punch Cards

ORGANIZATIONAL DATA HD6846 COMBINATION ROM-I/O-TIMER																																																											
Customer:		Hitachi Use Only:																																																									
Company	_____	Quote:	_____																																																								
Part No.	_____	Part No.:	_____																																																								
Originator	_____	Specif. No.:	_____																																																								
Phone No.	_____																																																										
Enable Options: (ROM ENABLE MUST DIFFER FROM I/O-TIMER)																																																											
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x	x	x	x	1																																																							
x	x	x	x	1																																																							

Figure 18 Format for Programming General Options

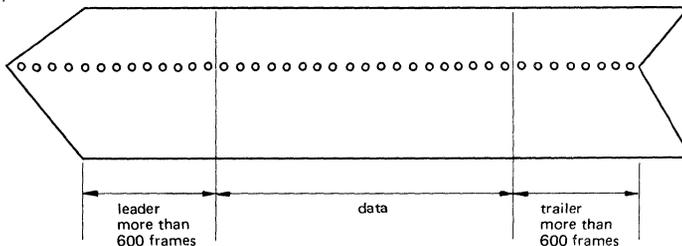
DATE									
COMPANY	ENGINEER SECTION								
CUSTOMERS P/N (if you need)	TYPE NO. OF ROM								
<table border="1" style="width: 100%; border-collapse: collapse;"> <tr> <td style="width: 50%; text-align: center;">1. HMCS6800 load module format</td> <td style="width: 50%; text-align: center;">2. BNP format</td> </tr> </table>	1. HMCS6800 load module format	2. BNP format							
1. HMCS6800 load module format	2. BNP format								
coding media <input type="checkbox"/> 1. paper tape <input type="checkbox"/> 2. IBM 80 column card	total bytes of data (decimal) _____ initial ROM address (decimal) _____ parity (for paper tape) <input type="checkbox"/> 1. even <input type="checkbox"/> 2. odd <input type="checkbox"/> 3. none total number of cards _____								
for HITACHI reference only <table border="1" style="width: 100%; border-collapse: collapse;"> <tr> <td style="width: 50%;">ref. No.</td> <td style="width: 50%;">_____</td> </tr> <tr> <td>mask ROM No.</td> <td>_____</td> </tr> <tr> <td>processed data</td> <td>_____</td> </tr> <tr> <td>approved data</td> <td>_____</td> </tr> </table>	ref. No.	_____	mask ROM No.	_____	processed data	_____	approved data	_____	designed _____ approved _____
ref. No.	_____								
mask ROM No.	_____								
processed data	_____								
approved data	_____								

Figure 19 Confirmation sheet of specification for HD6846 series ROM

■ PAPER TAPE

- 1) Any one inch width tape usually available in market can be used but tape in black color is recommended.
- 2) Both leader and trailer have more than 600 frames.

(Example)



- 3) One file data of each chip shall be contained in one reel of paper tape. One file data shall not be divided into more than two reels.
- 4) Parity
 - Parity shall be indicated in "Confirmation sheet of specification". Parity forms are grouped;
 - (1) With parity EVEN or ODD
 - (2) Without parity
- 5) 8-bit ASCII code shall be used.

column	contents
1 to 71	Free format of data column
72	Blank
73 to 80	Sequential card number, not free format. Least significant digit of decimal sequential number is located in column 80. No alphabet letters. Any sequential number more than 1 can be used.

■ CARD

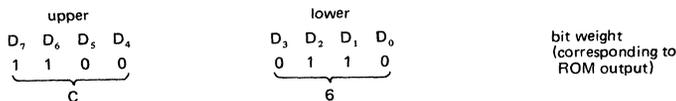
- 1) Use IBM 80 column card.
- 2) Use EBCDIC code.
- 3) Card format is as follows;
- 4) Total number of cards shall be written in "Confirmation sheet of specification".

■ DATA FORMAT

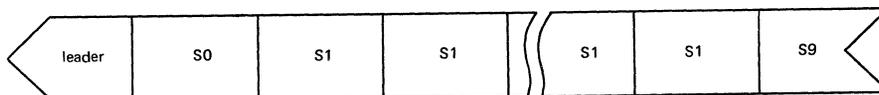
● HMCS6800 LOAD MODULE FORMAT

- This is object format obtained from HMCS6800 assembler.
- 1) 8-bit code is divided into upper and lower 4 bits and transformed into hexadecimal number.

(Example) Binary number if 1100 0010 is transformed as follows.

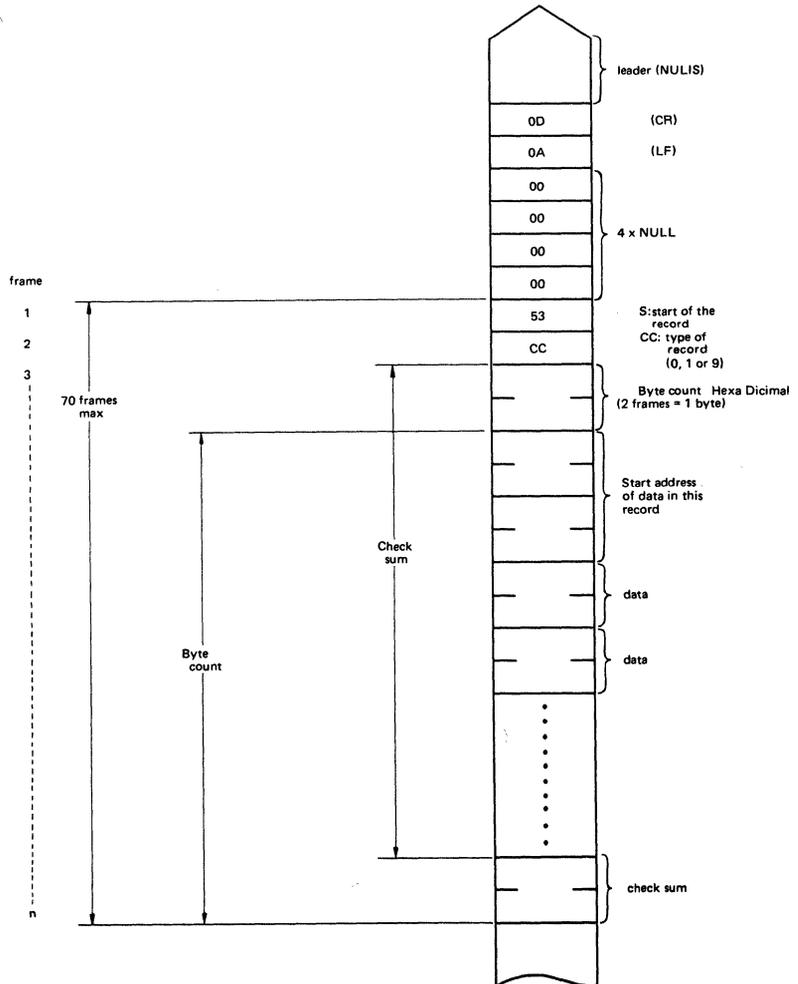
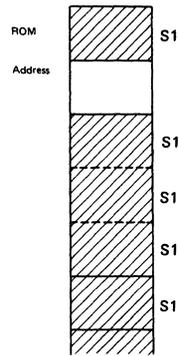


- 2) Load module structure of paper tape is shown as an example.



S0 is the header record, S1 is data record and S9 is end of file record. Each data record corresponds to each ROM data as shown below. Continuous memory address shall be divided into several records due to limitation of maximum frame number (70 frames = 35 bytes) in one record.

S0, S1 or S9 is distinguished by CC following start of the record S.



Check sum is complement of 1 for sum of each 8-bit.

3) Example of load module format

frame	CC=30 header record		CC=31 data record		CC=39 end of file record	
1 start of record	53	S	53	S	53	S
2 type of record	30	0	31	1	39	9
3	30		31		30	
4 byte count	36	06	36	16	33	03
5	30		31		30	
6 start address of	30		31		30	
7 data in this	30	0000	30	1100	30	0000
8 record	30		30		30	
9 data	34	48-H	39	98	46	FC (check sum)
10 data	38		38		43	
	34	44-D	30	02		
	34		32			
	35	52-R				
	32					
n check sum	42	2B (check sum)	41	A8 (check sum)		

Check sum of header record above is complement of 1 of $(06 + 00 + 00 + 48 + 44 + 52)_{16}$ i.e., 2B.

The start address of data record is incremented for each one byte data, then is compared to the next address in data record and is checked to be sequential or not.

When it is not sequential, hexadecimal 00 is filled as data for that address automatically.

A example of type out of paper tape in HMCS6800 load module format is shown below.

```
header record ...S00600004844522B
data record .....S113F0007EF5587EF7897EFAA77EF9C07EF9C47E24
data record .....S112F010FA657EFA8B7EFAA07EF9DC7EFA247E06
end of file record ....S9030000FC
```

4) Four types of data of ROM code are able to be processed. In any case, header record before data record is needed and so as end of file record after data record.

(a) No vacancy in ROM

Data record is filled with full ROM record of one chip. Therefore address is sequential. Initial ROM address in "Confirmation sheet of specification" is 0.

(b) Vacancy in former part of ROM

Desired initial address shall be filled in initial ROM address column in "Confirmation sheet of specification". Data of 00 are filled automatically for vacant address.

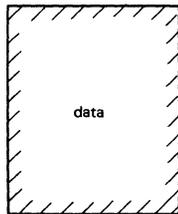
(c) Vacancy in the middle of ROM

Data of 00 are filled in for vacant address. Initial ROM address for data I is 0 and desired initial address for data II shall be described in "Confirmation sheet of specification".

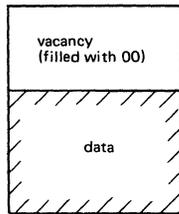
(d) Vacancy in later part of ROM

When end of file record is read out, data of 00 are filled in thereafter.

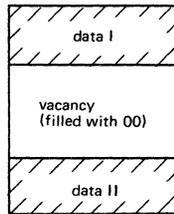
ROM



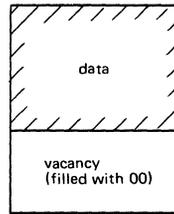
(a)



(b)

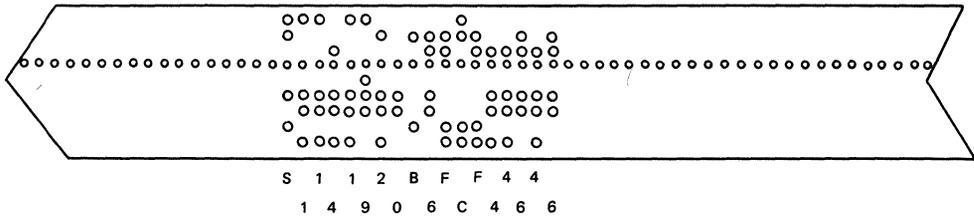


(c)



(d)

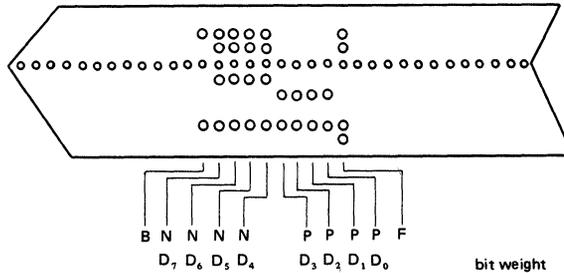
(Example) Paper tape whose data record is S1141920B6FC



● BPNF format

- 1) Each word is expressed as BPNF slice which begins word opening mark B, has 8 character bit contents shown by P or N and finishes with end mark F.

(Example) 0F in hexadecimal code is expressed as shown below (paper tape).



- 2) Any contents between F of the first slice and B of next slice are disregarded.
- 3) Bit pattern (BNPF) slice for all ROM address shall be indicated. Initial ROM address in "Confirmation sheet of specification" is, therefore always 0 for BNPF.
 B shows beginning of the word
 N shows 0 of one bit data
 P shows 1 of one bit data
 F shows end of the word

Note 1) X can be used expect for P and N for indication of word contents of BPNF slice. This X means that bit can be either P or N (don't care). X shall be determined by HITACHI for testing and shall be

Note 2) informed to the customer in confirmation table. Expression of B*nF can be used for indicating that the same contents of foregoing slice are applicable from this word to following n words.

For example, when B*4F is indicated at 10th word position, the contents of 9th word are repeated for 10, 11, 12 and 13th word. (Content of X is not always repeated even in this case.)

Note 3) n is greater than 1 and less than final address of ROM. When vacancy of ROM exists, combination of Note 1) and Note 2) is usefull.

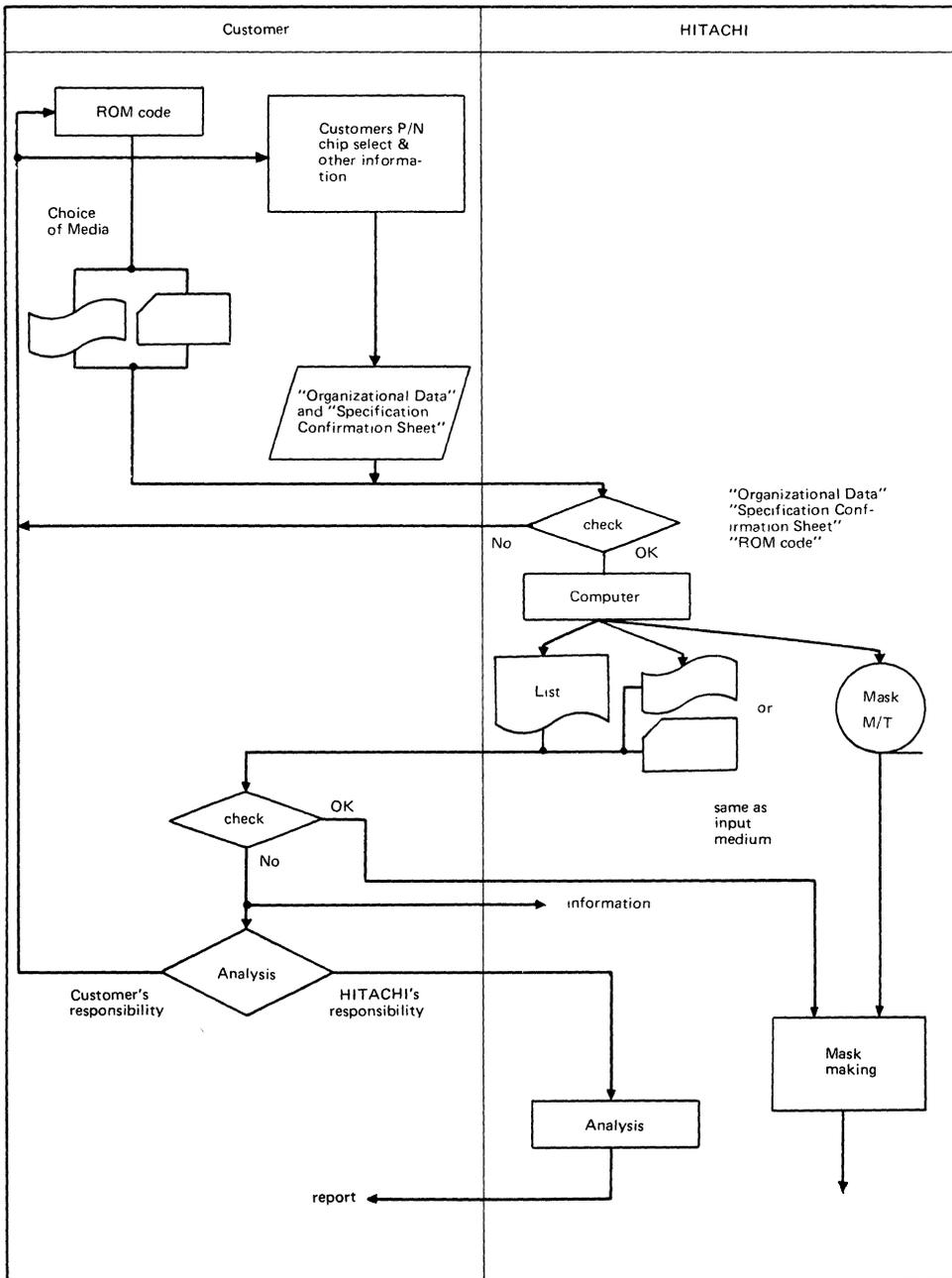


Figure 20 Flow chart of Mask ROM Development

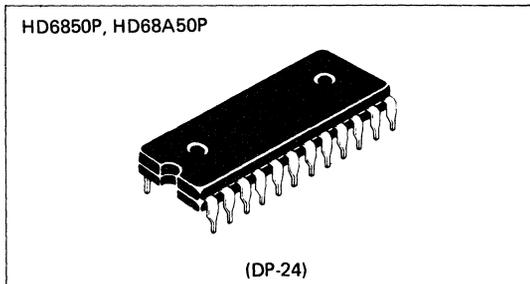
HD6850, HD68A50

ACIA (Asynchronous Communications Interface Adapter)

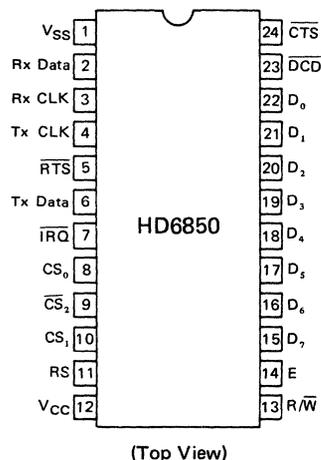
The HD6850 Asynchronous Communications Interface Adapter provides the data formatting and control to interface serial asynchronous data communications information to bus organized systems such as the HMCS6800 Microprocessing Unit.

The bus interface of the HD6850 includes select, enable, read/write, interrupt and bus interface logic to allow data transfer over an 8-bit bi-directional data bus. The parallel data of the bus system is serially transmitted and received by the asynchronous data interface, with proper formatting and error checking.

The functional configuration of the ACIA is programmed via the data bus during system initialization. A programmable Control Register provides variable word lengths, clock division ratios, transmit control, receive control, and interrupt control. For peripheral or modem operation three control lines are provided.



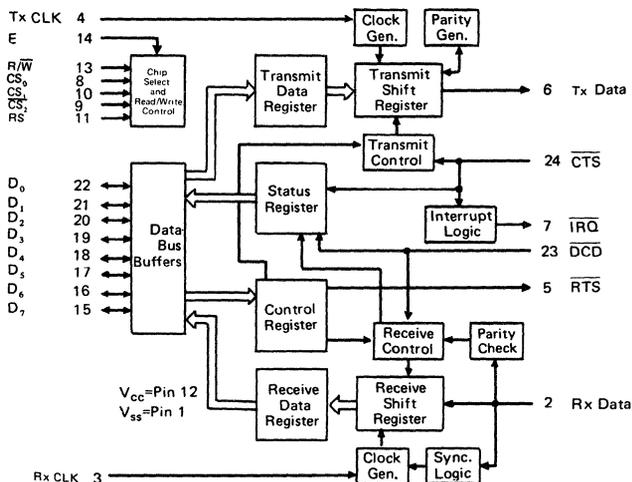
■ PIN ARRANGEMENT



■ FEATURES

- Serial/Parallel Conversion of Data
- Eight and Nine-bit Transmission
- Insertion and Deleting of Start and Stop Bit
- Optional Even and Odd Parity
- Parity, Overrun and Framing Error Checking
- Peripheral/Modem Control Functions (Clear to Send CTS, Request to Send RTS, Data Carrier Detect DCD)
- Optional ÷ 1, ÷ 16, and ÷ 64 Clock Modes
- Up to 500kbps Transmission
- Programmable Control Register
- N-channel Silicon Gate Process
- Compatible with MC6850 and MC68A50

■ BLOCK DIAGRAM



■ ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Value	Unit
Supply Voltage	V_{CC}^*	-0.3 ~ +7.0	V
Input Voltage	V_{in}^*	-0.3 ~ +7.0	V
Operating Temperature	T_{opr}	-20 ~ +75	°C
Storage Temperature	T_{stg}	-55 ~ +150	°C

* With respect to V_{SS} (SYSTEM GND)

(NOTE) Permanent LSI damage may occur if maximum ratings are exceeded. Normal operation should be under recommended operating conditions. If these conditions are exceeded, it could affect reliability of LSI.

■ RECOMMENDED OPERATING CONDITIONS

Item	Symbol	min	typ	max	Unit
Supply Voltage	V_{CC}^*	4.75	5.0	5.25	V
Input Voltage	V_{IL}^*	-0.3	—	0.8	V
	V_{IH}^*	2.0	—	V_{CC}	V
Operating Temperature	T_{opr}	-20	25	75	°C

* With respect to V_{SS} (SYSTEM GND)

■ ELECTRICAL CHARACTERISTICS

● DC CHARACTERISTICS ($V_{CC}=5V \pm 5\%$, $V_{SS}=0V$, $T_a=-20 \sim +75^\circ C$, unless otherwise noted.)

Item	Symbol	Test Condition	min	typ*	max	Unit	
Input "High" Voltage	All Inputs	V_{IH}	2.0	—	V_{CC}	V	
Input "Low" Voltage	All Inputs	V_{IL}	-0.3	—	0.8	V	
Input Leakage Current	R/W, CS_0 , CS_1 , CS_2 , E	I_{in}	$V_{in}=0 \sim 5.25V$	-2.5	—	2.5	μA
Three-State (Off State) Input Current	$D_0 \sim D_7$	I_{TS1}	$V_{in}=0.4 \sim 2.4V$	-10	—	10	μA
Output "High" Voltage	$D_0 \sim D_7$	V_{OH}	$I_{OH}=-205\mu A$, Enable Pulse Width $\leq 25\mu s$	2.4	—	—	V
	TxData, \overline{RTS}		$I_{OH}=-100\mu A$, Enable Pulse Width $\leq 25\mu s$	2.4	—	—	
Output "Low" Voltage	All outputs	V_{OL}	$I_{OL}=1.6mA$, Enable Pulse Width $\leq 25\mu s$	—	—	0.4	V
Output Leakage Current (Off State)	\overline{IRQ}	I_{LOH}	$V_{OH}=2.4V$	—	—	10	μA
Power Dissipation		P_D		—	300	525	mW
Input Capacitance	$D_0 \sim D_7$	C_{in}	$V_{in}=0V$, $T_a=25^\circ C$, $f=1.0MHz$	—	—	12.5	pF
	E, TxCLK, RxCLK, R/W, RS, RxData, CS_0 , CS_1 , CS_2 , CTS, DCD			—	—	7.5	
Output Capacitance	RTS, TxData	C_{out}	$V_{in}=0V$, $T_a=25^\circ C$, $f=1.0MHz$	—	—	10	pF
	\overline{IRQ}			—	—	5.0	

* $T_a=25^\circ C$, $V_{CC}=5V$

● AC CHARACTERISTICS

1. TIMING OF DATA TRANSMISSION

Item		Symbol	Test Condition	min	typ	max	Unit
Minimum Clock Pulse Width	÷16, ÷64 Modes	PW _{CL}	Fig. 1	600	—	—	ns
	÷16, ÷64 Modes	PW _{CH}	Fig. 2	600	—	—	ns
Clock Frequency	÷1 Mode	f _c		—	—	500	kHz
	÷16, ÷64 Modes			—	—	800	
Clock-to-Data Delay for Transmitter		t _{TDD}	Fig. 3	—	—	1.0	μs
Receive Data Setup Time	÷ 1 Mode	t _{RDSU}	Fig. 4	500	—	—	ns
Receive Data Hold Time	÷ 1 Mode	t _{RDH}	Fig. 5	500	—	—	ns
IRQ Release Time		t _{IR}	Fig. 6	—	—	1.2	μs
RTS Delay Time		t _{RTS}	Fig. 6	—	—	1.0	μs
Rise Time and Fall Time	Except E	t _r , t _f		—	—	1.0*	μs

* 1.0 μs or 10% of the pulse width, whichever is smaller.

2. BUS TIMING CHARACTERISTICS

1) READ

Item	Symbol	Test Condition	HD6850			HD68A50			Unit
			min	typ	max	min	typ	max	
Enable Cycle Time	t _{cycE}	Fig. 7	1.0	—	—	0.666	—	—	μs
Enable "High" Pulse Width	PW _{EH}	Fig. 7	0.45	—	25	0.28	—	25	μs
Enable "Low" Pulse Width	PW _{EL}	Fig. 7	0.43	—	—	0.28	—	—	μs
Setup Time, Address and R/W valid to Enable positive transition	t _{AS}	Fig. 7	140	—	—	140	—	—	ns
Data Delay Time	t _{DDR}	Fig. 7	—	—	320	—	—	220	ns
Data Hold Time	t _H	Fig. 7	10	—	—	10	—	—	ns
Address Hold Time	t _{AH}	Fig. 7	10	—	—	10	—	—	ns
Rise and Fall Time for Enable Input	t _{Er} , t _{Ef}	Fig. 7	—	—	25	—	—	25	ns

2) WRITE

Item	Symbol	Test Condition	HD6850			HD68A50			Unit
			min	typ	max	min	typ	max	
Enable Cycle Time	t _{cycE}	Fig. 8	1.0	—	—	0.666	—	—	μs
Enable "High" Pulse Width	PW _{EH}	Fig. 8	0.45	—	25	0.28	—	25	μs
Enable "Low" Pulse Width	PW _{EL}	Fig. 8	0.43	—	—	0.28	—	—	μs
Setup Time, Address and R/W valid to Enable positive transition	t _{AS}	Fig. 8	140	—	—	140	—	—	ns
Data Setup Time	t _{DSW}	Fig. 8	195	—	—	80	—	—	ns
Data Hold Time	t _H	Fig. 8	10	—	—	10	—	—	ns
Address Hold Time	t _{AH}	Fig. 8	10	—	—	10	—	—	ns
Rise and Fall Time for Enable Input	t _{Er} , t _{Ef}	Fig. 8	—	—	25	—	—	25	ns

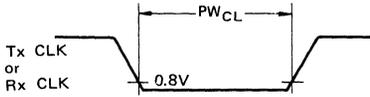


Figure 1 Clock Pulse Width, "Low" State

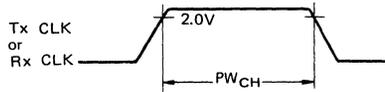


Figure 2 Clock Pulse Width, "High" State

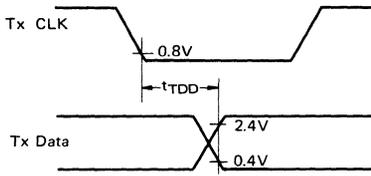


Figure 3 Transmit Data Output Delay

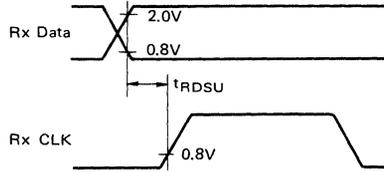


Figure 4 Receive Data Setup Time (±1 Mode)

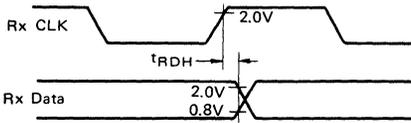
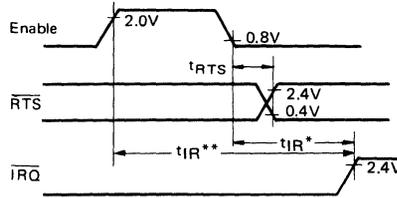


Figure 5 Receive Data Hold Time (±1 Mode)



- * (1) \overline{IRQ} Release Time applied to Rx Data Register read operation.
- (2) \overline{IRQ} Release Time applied to Tx Data Register write operation.
- (3) \overline{IRQ} Release Time applied to control Register write TIE = 0, RIE = 0 operation.

** \overline{IRQ} Release Time applied to Rx Data Register read operation right after read status register, when \overline{IRQ} is asserted by \overline{DCD} rising edge.

(Note) Note that followings take place when \overline{IRQ} is asserted by the detection of transmit data register empty status. \overline{IRQ} is released to "High" asynchronously with E signal when CTS goes "High". (Refer to Figure 14)

Figure 6 \overline{RTS} Delay and \overline{IRQ} Release Time

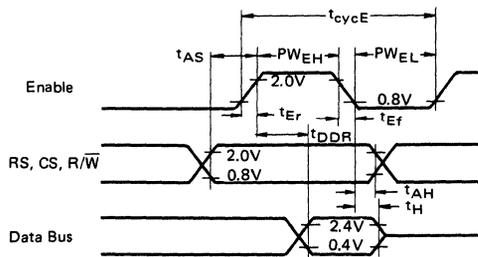


Figure 7 Bus Read Timing Characteristics (Read information from ACIA)

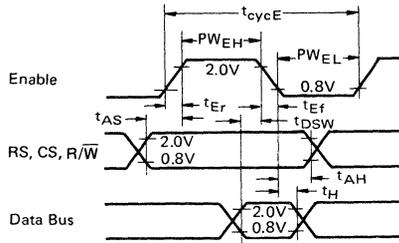


Figure 8 Bus Write Timing Characteristics (Write information into ACIA)

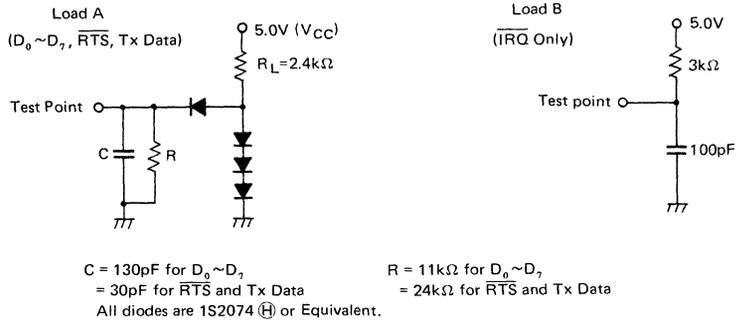


Figure 9 Bus Timing Test Loads

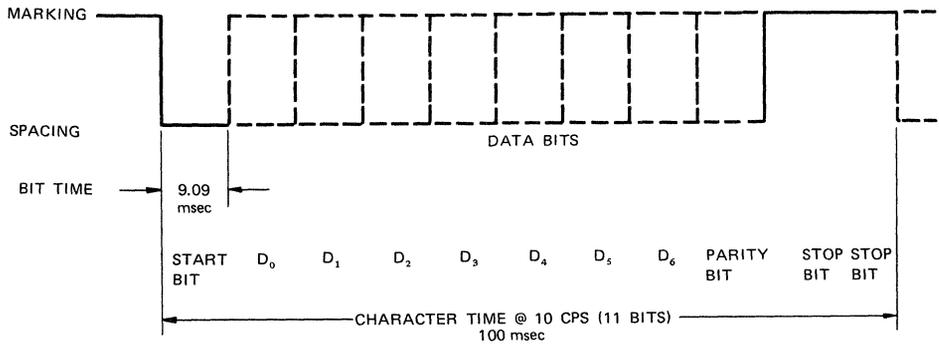
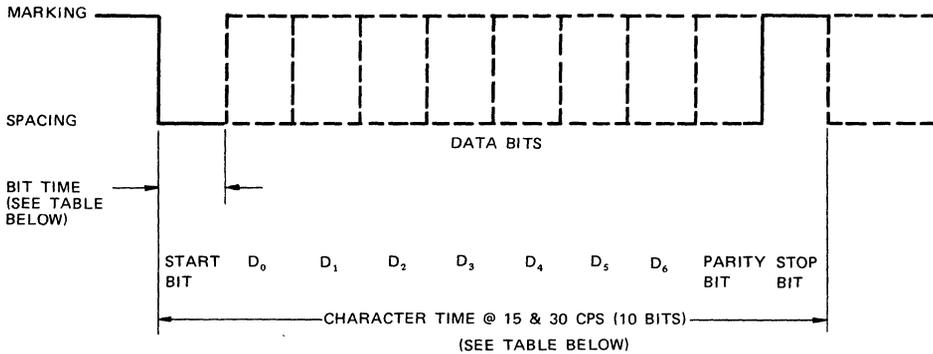


Figure 10 110 Baud Serial ASCII Data Timing



BAUD RATE	150	300
CHARACTERS/SEC	15	30
BIT TIME (msec)	6.67	3.33
CHARACTER TIME (msec)	66.7	33.3

$$\text{BIT TIME} = \frac{\text{SEC}}{\text{BAUD RATE}}$$

Figure 11 150 & 300 Baud Serial ASCII Data Timing

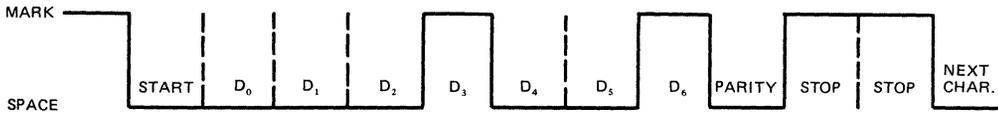


Figure 12 Send a 7 Bit ASCII Char. "H" Even Parity
 - 2 Stop Bits $H = 48_{16} = 1001000_2$

■ DATA OF ACIA

HD6850 is an interface adapter which controls transmission and reception of Asynchronous serial data. Some examples of serial data are shown in Figs. 10 ~ 12.

■ INTERNAL STRUCTURE OF ACIA

HD6850(ACIA) provides the following; 8-bit Bi-directional Data Buses (D₀~D₇), Receive Data Input (Rx Data), Transmit Data Output (Tx Data), three Chip Selects (CS₀, CS₁, CS₂), Register Select Input (RS), Two Control Input (Read/Write (R/W), Enable(E), Interrupt Request Output(IRQ), Clear-to-Send (CTS) to control the modem, Request-to-Send (RTS), Data Carrier Detect(DCD) and Clock Inputs(Tx CLK, Rx CLK) used for synchronization of received and transmitted data. This ACIA also provides four registers; Status Register, Control Register, Receive Register and Transmit Register.

24-pin dual-in-line type package is used for the ACIA. Internal Structure of ACIA is illustrated in Fig. 13.

■ ACIA OPERATION

● Master Reset

ACIA has an internal master reset function controlled by software, since it has no hardware reset pin. Bit 0 and bit 1 of control register should be set to "11" to execute master reset, also bit 5 and bit 6 should be programmed to get predetermined RTS output accordingly. To release the master reset, the data other than "11" should be written into bit 0, bit 1 of the control register. When the master reset is released, the control register needs to be programmed to get predetermined options such as clock divider ratios, word length, one or two stop bits, parity (even, odd, or none), etc.

It may happen that "Low" level output is provided in IRQ pin during the time after power-on till master reset. In the system using ACIA, interrupt mask bit of MPU should be released after the master reset of ACIA. (MPU interrupt should be prohibited until MPU program completes the master reset of ACIA.) Transmit Data Register (TDR) and Receive Data Register (RDR) can not be reset by master reset.

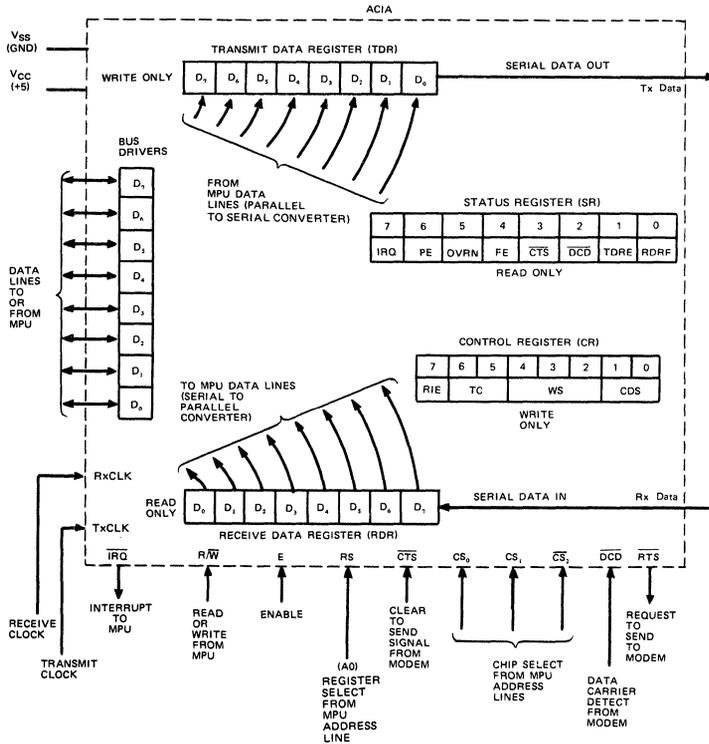


Figure 13 Internal Structure of ACIA

• **Transmit**

A typical transmitting sequence consists of reading the ACIA Status Register either as a result of an interrupt or in the ACIA's turn in a polling sequence. A character may be written into the Transmit Data Register if the status read operation has indicated that the Transmit Data Register is empty. This character is transferred to a Shift Register where it is serialized and transmitted from the Transmit Data output preceded by a start bit and followed by one or two stop bits. Internal parity (odd or even) can be optionally added to the character and will occur between the last data bit and the first stop bit. After the first character is written in the Data Register, the Status Register can be read again to check for a Transmit Data Register Empty condition and current peripheral status. If the register is empty, another character can be loaded for transmission even though the first character is in the process of being transmitted (because of double buffering). The second character will be automatically transferred into the Shift Register when the first character transmission is completed. This sequence continues until all the characters have been transmitted.

• **Receive**

Data is received from a peripheral by means of the Receive Data input. A divide-by-one clock ratio is provided for an externally synchronized clock (to its data) while the divide-by-16 and 64 ratios are provided for internal synchronization. Bit synchronization in the divide-by-16 and 64 modes is initiated by

the detection of the leading mark-space transition of the start bit. False start bit detection capability insures that a full half bit of a start bit has been received before the internal clock is synchronized to the bit time. As a character is being received, parity (odd or even) will be checked and the error indication will be available in the Status Register along with framing error, overrun error, and Receive Data Register full. In a typical receiving sequence, the Status Register is read to determine if a character has been received from a peripheral. If the Receiver Data Register is full, the character is placed on the 8-bit ACIA bus when a Read Data command is received from the MPU. When parity has been selected for an 8-bit word (7 bits plus parity), the receiver strips the parity bit (D₇="0") so that data alone is transferred to the MPU. This feature reduces MPU programming. The Status Register can continue to be read again to determine when another character is available in the Receive Data Register. The receiver is also double buffered so that a character can be read from the data register as another character is being received in the Shift register. The above sequence continues until all characters have been received.

■ **ACIA INTERNAL REGISTERS**

The ACIA provides four registers; Transmit Data Register (TDR), Receive Data Register (RDR), Control Register (CR) and Status Register (SR). The content of each of the registers is summarized in Table 1.

Table 1 Definition of ACIA Register Contents

Buffer Address	****			
	RS=1 · R/W=0	RS=1 · R/W=1	RS=0 · R/W=0	RS=0 · R/W=1
Data Bus	Transmit Data Register	Receiver Data Register	Control Register	Status Register
	(Write Only)	(Read Only)	(Write Only)	(Read Only)
0	Data Bit 0*	Data Bit 0	Counter Divide Select (CR0)	Rx Data Reg. Full (RDRF)
1	Data Bit 1	Data Bit 1	Counter Divide Select (CR1)	Tx Data Reg. Empty (TDRE)
2	Data Bit 2	Data Bit 2	Word Select 1 (CR2)	Data Carrier Detect (DCD)
3	Data Bit 3	Data Bit 3	Word Select 2 (CR3)	Clear to Send (CTS)
4	Data Bit 4	Data Bit 4	Word Select 3 (CR4)	Framing Error (FE)
5	Data Bit 5	Data Bit 5	Tx Control 1 (CR5)	Overrun (OVRN)
6	Data Bit 6	Data Bit 6	Tx Control 2 (CR6)	Parity Error (PE)
7	Data Bit 7***	Data Bit 7**	Rx Interrupt Enable (CR7)	Interrupt Request (IRQ)

* Leading bit = LSB = Bit 0

** Data bit will be zero in 7-bit plus parity modes.

*** Data bit is "don't care" in 7-bit plus parity modes.

**** 1 ... "High" level, 0 ... "Low" level

● Transmit Data Register (TDR)

Data is written in the Transmit Data Register during the negative transition of the enable (E) when the ACIA has been addressed and $RS \cdot R/W$ is selected. Writing data into the register causes the Transmit Data Register Empty bit in the Status Register to go "0". Data can then be transmitted. If the transmitter is idling and no character is being transmitted, then the transfer will take place within 2 bit time + several E cycles of the trailing edge of the Write command. If a character is being transmitted, the new data character will commence as soon as the previous character is complete. The transfer of data causes the Transmit Data Register Empty (TDRE) bit to indicate empty.

● Receive Data Register (RDR)

Data is automatically transferred to the empty Receive Data Register (RDR) from the receiver deserializer (a shift register) upon receiving a complete character. This event causes the Receive Data Register Full bit (RDRF) on the status buffer to go "1" (full). Data may then be read through the bus by addressing the ACIA and R/W "High" when the ACIA is enabled. The non-destructive read cycle causes the RDRF bit to be cleared to empty although the data is retained in the RDR. The status is maintained by RDRF as to whether or not the data is current. When the Receive Data Register is full, the automatic transfer of data from the Receiver Shift Register to the Data Register is inhibited and the RDR contents remain valid with its current status stored in the Status Register.

● Control Register

The ACIA Control Register consists of eight bits of write-only buffer that are selected when RS and R/W are "Low". This

register controls the function of the receiver, transmitter, interrupt enables, and the Request-to-Send (RTS) peripheral/modem control output.

Counter Divide Select Bits (CR0 and CR1)

The Counter Divide Select Bits (CR0 and CR1) determine the divide ratios utilized in both the transmitter and receiver section of the ACIA. Additionally, these bits are used to provide a master reset for the ACIA which clears the Status Register (except for external conditions on CTS and DCD) and initializes both the receiver and transmitter. Master reset does not affect other Control Register bits. Note that after power-on or a power fail/restart, these bits must be set "1" to reset the ACIA. After resetting, the clock divide ratio may be selected. These counter select bits provide for the following clock divide ratios:

Table 2 Function of Counter Divide Select Bit

CR1	CR0	Function
0	0	÷1
0	1	÷16
1	0	÷64
1	1	Master Reset

Word Select Bits (CR2, CR3, and CR4)

The Word Select bits are used to select word length, parity, and the number of stop bits. The encoding format is as follows:

Table 3 Function of Word Select Bit

CR4	CR3	CR2	Function
0	0	0	7 Bits + Even Parity + 2 Stop Bits
0	0	1	7 Bits + Odd Parity + 2 Stop Bits
0	1	0	7 Bits + Even Parity + 1 Stop Bit
0	1	1	7 Bits + Odd Parity + 1 Stop Bit
1	0	0	8 Bits + 2 Stop Bits
1	0	1	8 Bits + 1 Stop Bit
1	1	0	8 Bits + Even Parity + 1 Stop Bit
1	1	1	8 Bits + Odd Parity + 1 Stop Bit

Word length, Parity Select, and Stop Bit changes are not buffered and therefore become effective immediately.

Transmitter Control Bits (CR5 and CR6)

Two Transmitter Control bits provide for the control of the interrupt from the Transmit Data Register Empty condition, the Request-to-Send (RTS) output, and the transmission of a Break level (space). The following encoding format is used:

Table 4 Function of Transmitter Control-Bit

CR6	CR5	Function
0	0	RTS = "Low", Transmitting Interrupt Disabled.
0	1	RTS = "Low", Transmitting Interrupt Enabled.
1	0	RTS = "High", Transmitting Interrupt Disabled.
1	1	RTS = "Low", Transmits a Break level on the Transmit Data Output. Transmitting Interrupt Disabled.

Receive Interrupt Enable Bit (CR7)

The following interrupts will be enabled by a "1" in bit position 7 of the Control Register (CR7): Receive Data Register Full, Overrun, or a "Low" to "High" transition on the Data Carrier Detect (DCD) signal line.

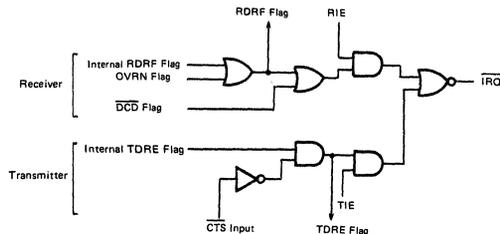


Figure 14 IRQ Internal Circuit

• Status Register

Information on the status of the ACIA is available to the MPU by reading the ACIA Status Register. This read-only register is selected when RS is "Low" and R/W is "High". Information stored in this register indicates the status of the Transmit Data Register, the Receive Data Register and error logic, and the peripheral/modem status inputs of the ACIA.

Receive Data Register Full (RDRF), Bit 0

RDRF indicates that received data has been transferred to the Receive Data Register. RDRF is cleared after an MPU read of the Receive Data Register or by a master reset. The cleared or empty state indicates that the contents of the Receive Data Register are not current. Data Carrier Detect (DCD) being "High" also causes RDRF to indicate empty.

Transmit Data Register Empty (TDRE), Bit 1

The Transmit Data Register Empty bit being set "1" indicates that the Transmit Data Register contents have been transferred and that new data may be entered. The "0" state indicates that the register is full and that transmission of a new character has not begun since the last write data command.

Data Carrier Detect (DCD), Bit 2

The DCD bit will be "1" when the DCD input from a modem has gone "High" to indicate that a carrier is not present. This bit going "1" causes an Interrupt Request to be generated when the Receive Interrupt Enable is set. It remains "1" after the DCD input is returned "Low" until cleared by first reading the Status Register and then the Data Register or until a master reset occurs. If the DCD input remains "High" after read status and read data or master reset has occurred, the interrupt is cleared, the DCD status bit remains "1" and will follow the DCD input.

Clear-to-Send (CTS), Bit 3

The CTS bit indicates the state of the CTS input from a modem. A "Low" CTS indicates that there is a CTS from the modem. In the "High" state, the Transmit Data Register Empty bit is inhibited and the CTS status bit will be "1". Master reset does not affect the Clear-to-Send Status bit.

Framing Error (FE), Bit 4

FE indicates that the received character is improperly framed by a start and a stop bit and is detected by the absence of the 1st stop bit. This error indicates a synchronization error, faulty transmission, or a break condition. The FE flag is set or reset during the receive data transfer time. Therefore, this error indicator is present throughout the time that the associated character is available.

Receiver Overrun (OVRN), Bit 5

Overrun is an error flag that indicates that one or more characters in the data stream were lost. That is, a character or a number of characters were received but not read from the Receive Data Register (RDR) prior to subsequent characters being received. The overrun condition begins at the midpoint of the last bit of the second character received in succession without a read of the RDR having occurred. The overrun does not occur in the Status Register until the valid character prior to Overrun has been read. The RDRF bit remains set until the Overrun is reset. Character synchronization is maintained during the Overrun condition. The Overrun indication is reset after the reading of data from the Receive Data Register or by a Master Reset.

Parity Error (PE), Bit 6

The PE flag indicates that the number of "1"s (highs) in the character does not agree with the preselected odd or even parity. Odd parity is defined to be when the total number of ones is odd. The parity error indication will be present as long as the data character is in the RDR. If no parity is selected, then both the transmitter parity generator output and the receiver parity check results are inhibited.

Interrupt Request (IRQ), Bit 7

The IRQ bit indicates the state of the $\overline{\text{IRQ}}$ output. Any interrupt condition with its applicable enable will be indicated in this status bit. Anytime the $\overline{\text{IRQ}}$ output is "Low" the IRQ bit will be "1" to indicate the interrupt or service request status. IRQ is cleared by a read operation to the Receive Data Register or a write operation to the Transmit Data Register. (Refer to Figure 14.)

■ SIGNAL FUNCTIONS**● Interface Signal for MPU****Bi-Directional Data Bus ($D_0 \sim D_7$)**

The bi-directional data bus ($D_0 \sim D_7$) allow for data transfer between the ACIA and the MPU. The data bus output drivers are three-state devices that remain in the high impedance (off) state except when the MPU performs an ACIA read operation.

Enable (E)

The Enable signal, E, is a high impedance TTL compatible input that enables the bus input/output data buffers and clocks data to and from the ACIA. This signal will normally be a derivative of the HMCS6800 ϕ_2 Clock.

Read/Write (R/ \overline{W})

The R/ \overline{W} line is a high impedance input that is TTL compatible and is used to control the direction of data flow through the ACIA's input/output data bus interface. When R/ \overline{W} is "High" (MPU Read cycle), ACIA output drivers are turned on and a selected register is read. When it is "Low", the ACIA output drivers are turned off and the MPU writes into a selected register. Therefore, the R/ \overline{W} signal is used to select read-only or write-only registers within the ACIA.

Chip Select (CS_0 , CS_1 , $\overline{CS_2}$)

These three high impedance TTL compatible input lines are used to address the ACIA. The ACIA is selected when CS_0 and CS_1 are "High" and $\overline{CS_2}$ is "Low". Transfers of data to and from the ACIA are then performed under the control of the Enable signal, Read/Write, and Register Select.

Register Select (RS)

The RS line is a high impedance input that is TTL compatible. A "High" level is used to select the Transmit/Receive Data Registers and a "Low" level the Control/Status Registers. The R/ \overline{W} signal line is used in conjunction with Register Select to select the read-only or write-only register in each register pair.

Interrupt Request ($\overline{\text{IRQ}}$)

$\overline{\text{IRQ}}$ is a TTL compatible, open-drain (no internal pullup), active "Low" output that is used to interrupt the MPU. The $\overline{\text{IRQ}}$ output remains "Low" as long as the cause of the interrupt is present and the appropriate interrupt enable within the ACIA is set.

Clock Inputs

Separate high impedance TTL compatible inputs are provided for clocking of transmitted and received data. Clock frequencies of 1, 16 or 64 times the data rate may be selected.

Transmit Clock (Tx CLK)

The Tx CLK input is used for the clocking of transmitted data. The transmitter initiates data on the negative transition of the clock.

Receive Clock (Rx CLK)

The Rx CLK input is used for synchronization of received data. (In the $\div 1$ mode, the clock and data must be synchronized externally.) The receiver samples the data on the positive transition of the clock.

● Serial Input/Output Lines**Receive Data (Rx Data)**

The Rx Data line is a high impedance TTL compatible input through which data is received in a serial format. Synchronization with a clock for detection of data is accomplished internally when clock rates of 16 or 64 times the bit rate are used. Data rates are in the range of 0 to 500 kbps when external synchronization is utilized.

Transmit Data (Tx Data)

The Tx Data output line transfers serial data to a modem or other peripheral. Data rates in the range of 0 to 500 kbps when external synchronization is utilized.

Modem Control

The ACIA includes several functions that permit limited control of a peripheral or modem. The functions included are $\overline{\text{CTS}}$, $\overline{\text{RTS}}$ and $\overline{\text{DCD}}$.

Clear-to-Send ($\overline{\text{CTS}}$)

This high impedance TTL compatible input provides automatic control of the transmitting end of a communications link via the modem $\overline{\text{CTS}}$ active "Low" output by inhibiting the Transmit Data Register Empty (TDRE) status bit. (Refer to Figure 15.)

Request-to-Send ($\overline{\text{RTS}}$)

The $\overline{\text{RTS}}$ output enables the MPU to control a peripheral or modem via the data bus. The $\overline{\text{RTS}}$ output corresponds to the state of the Control Register bits CR5 and CR6. When CR6=0 or both CR5 and CR6=1, the $\overline{\text{RTS}}$ output is "Low" (the active state). This output can also be used for Data Terminal Ready ($\overline{\text{DTR}}$). (Refer to Figure 15.)

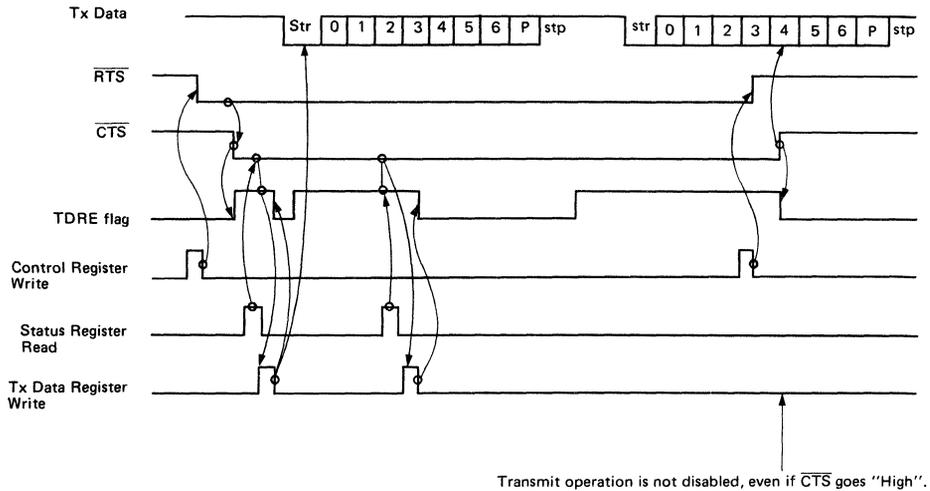


Figure 15 $\overline{\text{RTS}}$ and $\overline{\text{CTS}}$ Timing Chart (Example of 2 bytes transmission)

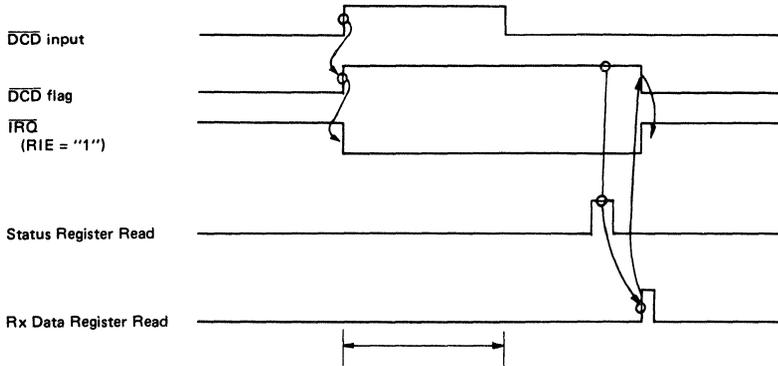
Data Carrier Detect ($\overline{\text{DCD}}$)

$\overline{\text{DCD}}$ is the input signal corresponding to the "carrier detect" signal which shows carrier detect of modem.

$\overline{\text{DCD}}$ signal is used to control the receiving operation. When $\overline{\text{DCD}}$ input goes "High", ACIA stops all the receiving operation and sets receiving part in reset status. It means that receive shift register stops shifting, error detection circuit and synchronization circuit of receive clock are reset. When $\overline{\text{DCD}}$ is in "High" level, the receiving part of ACIA is kept in initial

status and the operation in the receiving part is prohibited. When $\overline{\text{DCD}}$ goes "Low", the receiving part is allowed to receive data. In this case, the following process is needed to reset $\overline{\text{DCD}}$ flag and restarts the receive operation. (Refer to Figure 16.)

- (1) Return $\overline{\text{DCD}}$ input from "High" to "Low".
- (2) Read status register. ($\overline{\text{DCD}}$ flag = "1")
- (3) Read receive data register (Uncertain data will be read.)



All the receiving operation are prohibited and ACIA is stopped in this period.

Figure 16 $\overline{\text{DCD}}$ Flag Timing Chart

HD6350, HD63A50, HD63B50

CMOS ACIA (Asynchronous Communications Interface Adapter)

The HD6350 CMOS Asynchronous Communications Interface Adapter provides the data formatting and control to interface serial asynchronous data communications information to bus organized systems such as the HMCS6800 Micro-processing Unit.

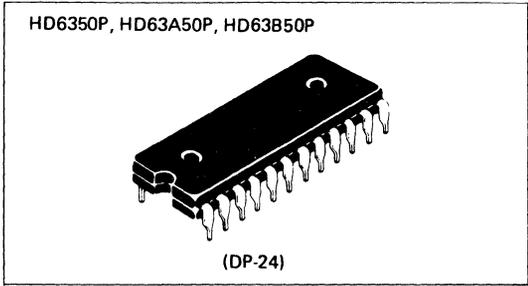
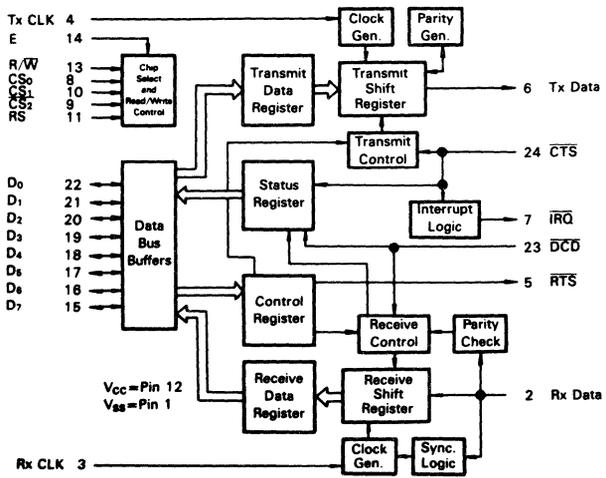
The bus interface of the HD6350 includes select, enable, read/write, interrupt and bus interface logic to allow data transfer over an 8-bit bi-directional data bus. The parallel data of the bus system is serially transmitted and received by the asynchronous data interface, with proper formatting and error checking.

The functional configuration of the ACIA is programmed via the data bus during system initialization. A programmable Control Register provides variable word lengths, clock division ratios, transmit control, receive control, and interrupt control. For peripheral or modem operation three control lines are provided. Exceeding Low Power dissipation is realized due to adopting CMOS process.

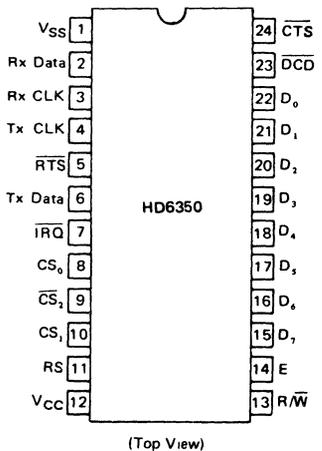
FEATURES

- Low-Power, High-Speed, High-Density CMOS
- Compatible with NMOS ACIA (HD6850)
- Serial/Parallel Conversion of Data
- Eight and Nine-bit Transmission
- Optional Even and Odd Parity
- Parity, Overrun and Framing Error Checking
- Peripheral/Modem Control Functions (Clear to Send CTS, Request to Send RTS, Data Carrier Detect DCD)
- Optional $\div 1$, $\div 16$, and $\div 64$ Clock Modes
- Up to 500kbps Transmission

BLOCK DIAGRAM



PIN ARRANGEMENT



■ ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Value	Unit
Supply Voltage	V_{CC}^*	-0.3 ~ +7.0	V
Input Voltage	V_{in}^*	-0.3 ~ +7.0	V
Maximum Output Current**	$ I_{O} $	10	mA
Operating Temperature	T_{opr}	-20 ~ +75	°C
Storage Temperature	T_{stg}	-55 ~ +150	°C

* With respect to V_{SS} (SYSTEM GND)

** Maximum output current is the maximum current which can flow out from one output terminal or I/O common terminal ($D_0 \sim D_7$, RTS , Tx Data, \overline{IRQ}).

(NOTE) Permanent LSI damage may occur if maximum ratings are exceeded. Normal operation should be under recommended operating conditions. If these conditions are exceeded, it could affect reliability of LSI.

■ RECOMMENDED OPERATING CONDITIONS

Item	Symbol	min	typ	max	Unit	
Supply Voltage	V_{CC}^*	4.5	5.0	5.5	V	
Input "Low" Voltage	V_{IL}^*	0	-	0.8	V	
Input "High" Voltage	$D_0 \sim D_7$, RS , Tx CLK, \overline{DCD} , \overline{CTS} , Rx Data	V_{IH}^*	2.0	-	V_{CC}	V
	CS_0 , $\overline{CS_2}$, CS_1 , R/\overline{W} , E , Rx CLK		2.2	-	V_{CC}	
Operating Temperature	T_{opr}	-20	25	75	°C	

* With respect to V_{SS} (SYSTEM GND)

■ ELECTRICAL CHARACTERISTICS

● DC CHARACTERISTICS ($V_{CC} = 5V \pm 10\%$, $V_{SS} = 0V$, $T_a = -20 \sim +75^\circ C$, unless otherwise noted.)

Item	Symbol	Test Condition	min	typ	max	Unit		
Input "High" Voltage	V_{IH}	$D_0 \sim D_7$, RS , Tx CLK, \overline{DCD} , \overline{CTS} , Rx Data	2.0	-	V_{CC}	V		
		CS_0 , $\overline{CS_2}$, CS_1 , R/\overline{W} , E , Rx CLK	2.2	-	V_{CC}			
Input "Low" Voltage	V_{IL}	All Inputs	-0.3	-	0.8	V		
Input Leakage Current	I_{in}	R/\overline{W} , CS_0 , CS_1 , $\overline{CS_2}$, E	$V_{in} = 0 \sim V_{CC}$	-2.5	-	2.5	μA	
Three-State (Off State) Input Current	I_{TSI}	$D_0 \sim D_7$	$V_{in} = 0.4 \sim V_{CC}$	-10	-	10	μA	
Output "High" Voltage	V_{OH}	$D_0 \sim D_7$	$I_{OH} = -400 \mu A$	4.1	-	-	V	
			$I_{OH} \leq -10 \mu A$	$V_{CC}-0.1$	-	-		
			$I_{OH} = -400 \mu A$	4.1	-	-		
			$I_{OH} \leq -10 \mu A$	$V_{CC}-0.1$	-	-		
Output "Low" Voltage	V_{OL}	All Outputs	$I_{OH} = 1.6 mA$	-	-	0.4	V	
Output Leakage Current (Off State)	I_{LOH}	\overline{IRQ}	$V_{OH} = V_{CC}$	-	-	10	μA	
Input Capacitance	C_{in}	$D_0 \sim D_7$	$V_{in} = 0V$, $T_a = 25^\circ C$, $f = 1.0 MHz$	-	-	12.5	pF	
				E , Tx CLK, Rx CLK, R/\overline{W} , RS , Rx Data, CS_0 , CS_1 , $\overline{CS_2}$, \overline{CTS} , \overline{DCD}	-	-		7.5
Output Capacitance	C_{out}	\overline{IRQ}	$V_{in} = 0V$, $T_a = 25^\circ C$, $f = 1.0 MHz$	-	-	10	pF	
				RTS , Tx Data	-	-		5.0
Supply Current	I_{CC}	<ul style="list-style-type: none"> • Under transmitting and Receiving operation • 500 kbps • Data bus in R/\overline{W} operation 	$E = 1.0 MHz$	-	-	3	mA	
			$E = 1.5 MHz$	-	-	4		
			$E = 2.0 MHz$	-	-	5		
			<ul style="list-style-type: none"> • Chip is not selected • 500 kbps • Under non transmitting and receiving operation • Input level (Except E) $V_{IH} \text{ min} = V_{CC}-0.8V$ $V_{IL} \text{ max} = 0.8V$ 	$E = 1.0 MHz$	-	-	200	μA
				$E = 1.5 MHz$	-	-	250	
$E = 2.0 MHz$	-	-	300					

● AC CHARACTERISTICS ($V_{CC} = 5.0V \pm 10\%$, $V_{SS} = 0V$, $T_a = -20 \sim +75^\circ C$, unless otherwise noted.)

1. TIMING OF DATA TRANSMISSION

Item	Symbol	Test Condition	HD6350		HD63A50		HD63B50		Unit	
			min	max	min	max	min	max		
Minimum Clock Pulse Width	÷ 1 Mode	PW _{CL}	Fig. 1	900	—	650	—	500	—	ns
				÷ 16, ÷ 64 Modes	600	—	450	—	280	—
	÷ 1 Mode	PW _{CH}	Fig. 2	900	—	650	—	500	—	ns
				÷ 16, ÷ 64 Modes	600	—	450	—	280	—
Clock Frequency	÷ 1 Mode	f _C	—	500	—	750	—	1000	kHz	
	÷ 16, ÷ 64 Modes		—	800	—	1000	—	1500	kHz	
Clock-to-Data Delay for Transmitter		t _{TDD}	Fig. 3	—	600	—	540	—	460	ns
Receive Data Setup Time		t _{RDSU}	Fig. 4	250	—	100	—	30	—	ns
Receive Data Hold Time		t _{RDH}	Fig. 5	250	—	100	—	30	—	ns
IRQ Release Time		t _{IR}	Fig. 6	—	1200	—	900	—	700	ns
RTS Delay Time		t _{RTS}	Fig. 6	—	560	—	480	—	400	ns
Rise Time and Fall Time		Except E	t _r , t _f	—	1000*	—	500	—	250	ns

* 1.0 μs or 10% of the pulse width, whichever is smaller.

2. BUS TIMING CHARACTERISTICS

1) READ

Item	Symbol	Test Condition	HD6350		HD63A50		HD63B50		Unit
			min	max	min	max	min	max	
Enable Cycle Time	t _{cycE}	Fig. 7	1000	—	666	—	500	—	ns
Enable "High" Pulse Width	PW _{EH}	Fig. 7	450	—	280	—	220	—	ns
Enable "Low" Pulse Width	PW _{EL}	Fig. 7	430	—	280	—	210	—	ns
Setup Time, Address and R/W Valid to Enable Positive Transition	t _{AS}	Fig. 7	80	—	60	—	40	—	ns
Data Delay Time	t _{DDR}	Fig. 7	—	290	—	180	—	150	ns
Data Hold Time	t _H	Fig. 7	20	100	20	100	20	100	ns
Address Hold Time	t _{AH}	Fig. 7	10	—	10	—	10	—	ns
Rise and Fall Time for Enable Input	t _{Er} , t _{Ef}	Fig. 7	—	25	—	25	—	20	ns

2) WRITE

Item	Symbol	Test Condition	HD6350		HD63A50		HD63B50		Unit
			min	max	min	max	min	max	
Enable Cycle Time	t _{cycE}	Fig. 8	1000	—	666	—	500	—	ns
Enable "High" Pulse Width	PW _{EH}	Fig. 8	450	—	280	—	220	—	ns
Enable "Low" Pulse Width	PW _{EL}	Fig. 8	430	—	280	—	210	—	ns
Setup Time, Address and R/W Valid to Enable Positive Transition	t _{AS}	Fig. 8	80	—	60	—	40	—	ns
Data Setup Time	t _{DSW}	Fig. 8	165	—	80	—	60	—	ns
Data Hold Time	t _H	Fig. 8	10	—	10	—	10	—	ns
Address Hold Time	t _{AH}	Fig. 8	10	—	10	—	10	—	ns
Rise and Fall Time for Enable Input	t _{Er} , t _{Ef}	Fig. 8	—	25	—	25	—	20	ns

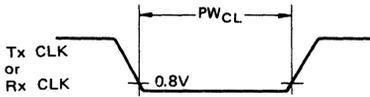
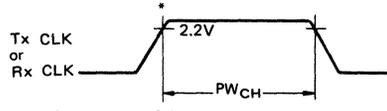


Figure 1 Clock Pulse Width, "Low" State



* Tx CLK is $V_{IH} = 2.0V$

Figure 2 Clock Pulse Width, "High" State

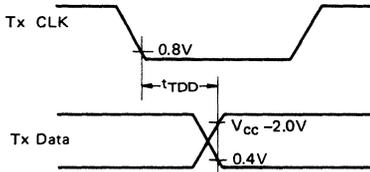


Figure 3 Transmit Data Output Delay

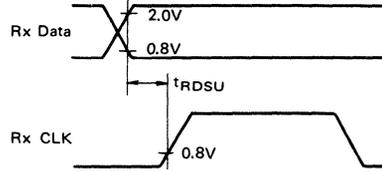


Figure 4 Receive Data Setup Time (± 1 Mode)

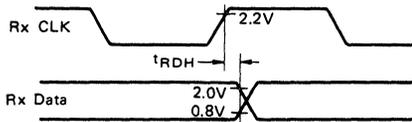
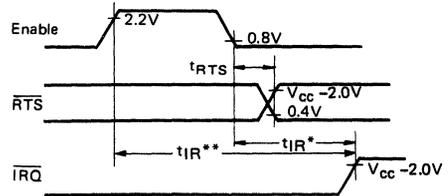


Figure 5 Receive Data Hold Time (± 1 Mode)



- * (1) \overline{IRQ} Release Time applied to Rx Data Register read operation.
- (2) \overline{IRQ} Release Time applied to Tx Data Register write operation.
- (3) \overline{IRQ} Release Time applied to control Register write TIE = 0, RIE = 0 operation.

** \overline{IRQ} Release Time applied to Rx Data Register read operation right after read status register, when \overline{IRQ} is asserted by \overline{DCD} rising edge.

(Note) Note that followings take place when \overline{IRQ} is asserted by the detection of transmit data register empty status. \overline{IRQ} is released to "High" asynchronously with E signal when CTS goes "High". (Refer to Figure 14)

Figure 6 \overline{RTS} Delay and \overline{IRQ} Release Time

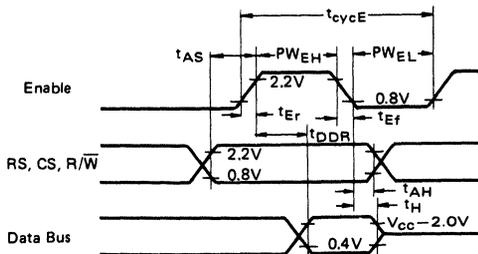


Figure 7 Bus Read Timing Characteristics (Read information from AC1A)

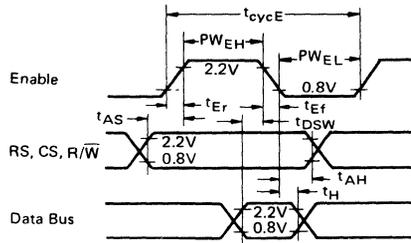
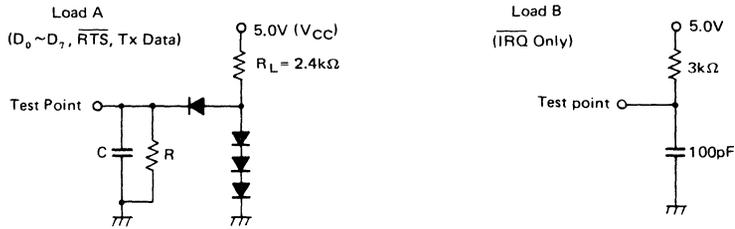


Figure 8 Bus Write Timing Characteristics (Write information into ACIA)



$C = 130pF$ for $D_0 \sim D_7$
 $= 30pF$ for \overline{RTS} and $Tx Data$
 $R = 10k\Omega$ for $D_0 \sim D_7, \overline{RTS}$ and $Tx Data$
 All diodes are .1S2074 or Equivalent.

Figure 9 Bus Timing Test Loads

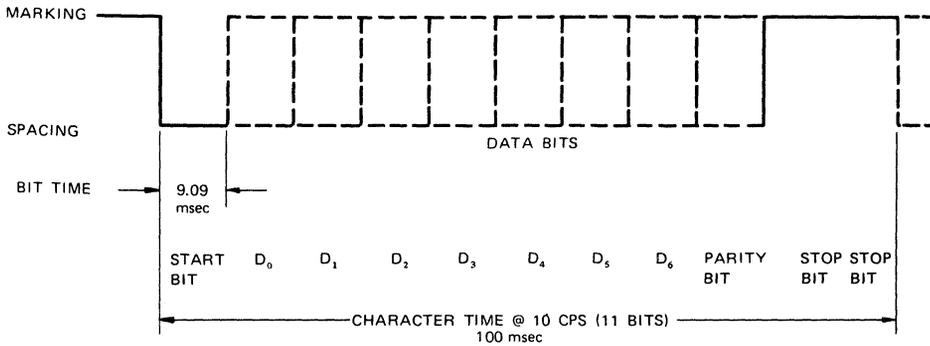
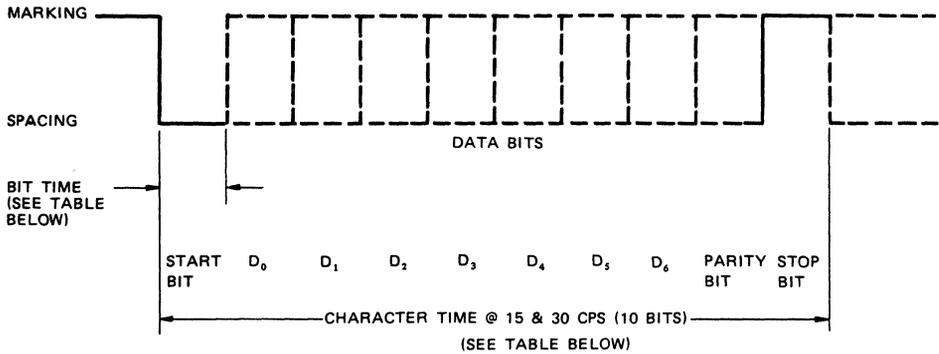


Figure 10 110 Baud Serial ASCII Data Timing



BAUD RATE	150	300
CHARACTERS/SEC	15	30
BIT TIME (msec)	6.67	3.33
CHARACTER TIME (msec)	66.7	33.3

$$\text{BIT TIME} = \frac{\text{SEC}}{\text{BAUD RATE}}$$

Figure 11 150 & 300 Baud Serial ASCII Data Timing

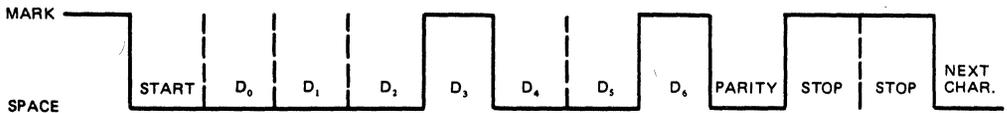


Figure 12 Send a 7 Bit ASCII Char. "H" Even Parity
 - 2 Stop Bits H = 48₁₆ = 1001000₂

■ DATA OF ACIA

HD6350 is an interface adapter which controls transmission and reception of Asynchronous serial data. Some examples of serial data are shown in Figs. 10 ~ 12.

■ INTERNAL STRUCTURE OF ACIA

HD6350(ACIA) provides the following; 8-bit Bi-directional Data Buses (D₀~D₇), Receive Data Input (Rx Data), Transmit Data Output (Tx Data), three Chip Selects (CS₀, CS₁, CS₂), Register Select Input (RS), Two Control Input (Read/Write: R/W, Enable: E), Interrupt Request Output (IRQ), Clear-to-Send (CTS) to control the modem, Request-to-Send (RTS), Data Carrier Detect (DCD) and Clock Inputs (Tx CLK, Rx CLK) used for synchronization of received and transmitted data. This ACIA also provides four registers; Status Register, Control Register, Receive Register and Transmit Register.

24-pin dual-in-line type package is used for the ACIA. Internal Structure of ACIA is illustrated in Fig. 13.

■ ACIA OPERATION

● Master Reset

ACIA has an internal master reset function controlled by software, since it has no hardware reset pin. Bit 0 and bit 1 of control register should be set to "11" to execute master reset, also bit 5 and bit 6 should be programmed to get predetermined RTS output accordingly. To release the master reset, the data other than "11" should be written into bit 0, bit 1 of the control register. When the master reset is released, the control register needs to be programmed to get predetermined options such as clock divider ratios, word length, one or two stop bits, parity (even, odd, or none), etc.

It may happen that "Low" level output is provided in IRQ pin during the time after power-on till master reset. In the system using ACIA, interrupt mask bit of MPU should be released after the master reset of ACIA. (MPU interrupt should be prohibited until MPU program completes the master reset of ACIA.) Transmit Data Register (TDR) and Receive Data Register (RDR) can not be reset by master reset.

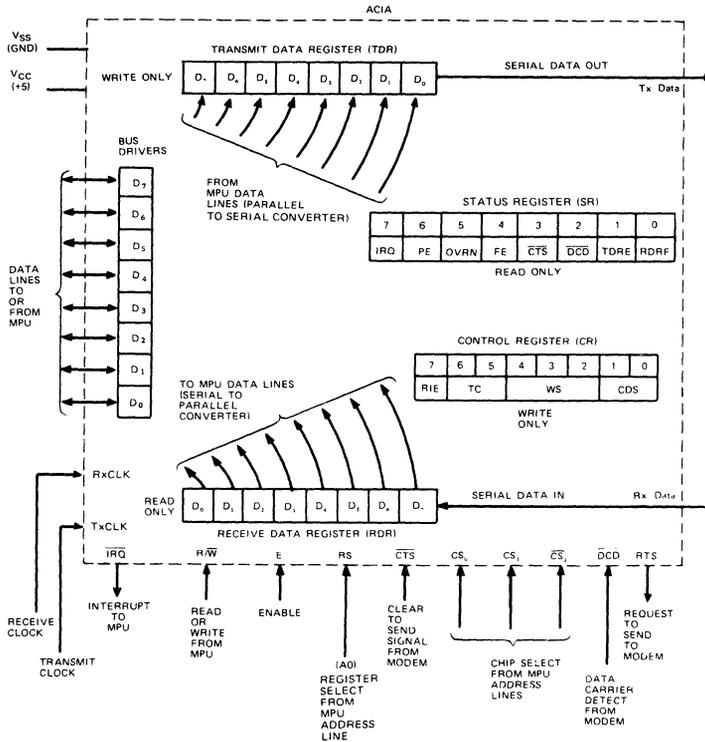


Figure 13 Internal Structure of ACIA

• **Transmit**

A typical transmitting sequence consists of reading the ACIA Status Register either as a result of an interrupt or in the ACIA's turn in a polling sequence. A character may be written into the Transmit Data Register if the status read operation has indicated that the Transmit Data Register is empty. This character is transferred to a Shift Register where it is serialized and transmitted from the Transmit Data output preceded by a start bit and followed by one or two stop bits. Internal parity (odd or even) can be optionally added to the character and will occur between the last data bit and the first stop bit. After the first character is written in the Data Register, the Status Register can be read again to check for a Transmit Data Register Empty condition and current peripheral status. If the register is empty, another character can be loaded for transmission even though the first character is in the process of being transmitted (because of double buffering). The second character will be automatically transferred into the Shift Register when the first character transmission is completed. This sequence continues until all the characters have been transmitted.

• **Receive**

Data is received from a peripheral by means of the Receive Data input. A divide-by-one clock ratio is provided for an externally synchronized clock (to its data) while the divide-by-16 and 64 ratios are provided for internal synchronization. Bit synchronization in the divide-by-16 and 64 modes is initiated by

the detection of the leading mark-space transition of the start bit. False start bit detection capability insures that a full half bit of a start bit has been received before the internal clock is synchronized to the bit time. As a character is being received, parity (odd or even) will be checked and the error indication will be available in the Status Register along with framing error, overrun error, and Receive Data Register full. In a typical receiving sequence, the Status Register is read to determine if a character has been received from a peripheral. If the Receiver Data Register is full, the character is placed on the 8-bit ACIA bus when a Read Data command is received from the MPU. When parity has been selected for an 8-bit word (7 bits plus parity), the receiver strip the parity bit ($D_7="0"$) so that data alone is transferred to the MPU. This feature reduces MPU programming. The Status Register can continue to be read again to determine when another character is available in the Receive Data Register. The receiver is also double buffered so that a character can be read from the data register as another character is being received in the Shift register. The above sequence continues until all characters have been received.

■ **ACIA INTERNAL REGISTERS**

The ACIA provides four registers; Transmit Data Register (TDR), Receive Data Register(RDR), Control Register(CR) and Status Register(SR). The content of each of the registers is summarized in Table I.

Table 1 Definition of ACIA Register Contents

Buffer Address	****			
	RS=1 · R/W=0	RS=1 · R/W=1	RS=0 · R/W=0	RS=0 · R/W=1
Data Bus	Transmit Data Register	Receiver Data Register	Control Register	Status Register
	(Write Only)	(Read Only)	(Write Only)	(Read Only)
0	Data Bit 0*	Data Bit 0	Counter Divide Select (CR0)	Rx Data Reg. Full (RDRF)
1	Data Bit 1	Data Bit 1	Counter Divide Select (CR1)	Tx Data Reg. Empty (TDRE)
2	Data Bit 2	Data Bit 2	Word Select 1 (CR2)	Data Carrier Detect (DCD)
3	Data Bit 3	Data Bit 3	Word Select 2 (CR3)	Clear to Send (CTS)
4	Data Bit 4	Data Bit 4	Word Select 3 (CR4)	Framing Error (FE)
5	Data Bit 5	Data Bit 5	Tx Control 1 (CR5)	Overrun (OVRN)
6	Data Bit 6	Data Bit 6	Tx Control 2 (CR6)	Parity Error (PE)
7	Data Bit 7***	Data Bit 7**	Rx Interrupt Enable (CR7)	Interrupt Request (IRQ)

- * Leading bit = LSB = Bit 0
- ** Data bit will be zero in 7-bit plus parity modes.
- *** Data bit is "don't care" in 7-bit plus parity modes.
- **** 1 ... "High" level, 0 ... "Low" level

● **Transmit Data Register (TDR)**

Data is written in the Transmit Data Register during the negative transition of the enable (E) when the ACIA has been addressed and $RS \cdot R/\bar{W}$ is selected. Writing data into the register causes the Transmit Data Register Empty bit in the Status Register to go "0". Data can then be transmitted. If the transmitter is idling and no character is being transmitted, then the transfer will take place within 2 bit time + several E cycles of the trailing edge of the Write command. If a character is being transmitted, the new data character will commence as soon as the previous character is complete. The transfer of data causes the Transmit Data Register Empty (TDRE) bit to indicate empty.

● **Receive Data Register (RDR)**

Data is automatically transferred to the empty Receive Data Register (RDR) from the receiver deserializer (a shift register) upon receiving a complete character. This event causes the Receive Data Register Full bit (RDRF) on the status buffer to go "1" (full). Data may then be read through the bus by addressing the ACIA and R/\bar{W} "High" when the ACIA is enabled. The non-destructive read cycle causes the RDRF bit to be cleared to empty although the data is retained in the RDR. The status is maintained by RDRF as to whether or not the data is current. When the Receive Data Register is full, the automatic transfer of data from the Receiver Shift Register to the Data Register is inhibited and the RDR contents remain valid with its current status stored in the Status Register.

● **Control Register**

The ACIA Control Register consists of eight bits of write-only buffer that are selected when RS and R/\bar{W} are "Low". This

register controls the function of the receiver, transmitter, interrupt enables, and the Request-to-Send (RTS) peripheral/modem control output.

● **Counter Divide Select Bits (CR0 and CR1)**

The Counter Divide Select Bits (CR0 and CR1) determine the divide ratios utilized in both the transmitter and receiver section of the ACIA. Additionally, these bits are used to provide a master reset for the ACIA which clears the Status Register (except for external conditions on CTS and DCD) and initializes both the receiver and transmitter. Master reset does not affect other Control Register bits. Note that after power-on or a power fail/restart, these bits must be set "1" to reset the ACIA. After resetting, the clock divide ratio may be selected. These counter select bits provide for the following clock divide ratios:

Table 2 Function of Counter Devide Select Bit

CR1	CR0	Function
0	0	÷1
0	1	÷16
1	0	÷64
1	1	Master Reset

● **Word Select Bits (CR2, CR3, and CR4)**

The Word Select bits are used to select word length, parity, and the number of stop bits. The encoding format is as follows:

Table 3 Function of Word Select Bit

CR4	CR3	CR2	Function
0	0	0	7 Bits + Even Parity + 2 Stop Bits
0	0	1	7 Bits + Odd Parity + 2 Stop Bits
0	1	0	7 Bits + Even Parity + 1 Stop Bit
0	1	1	7 Bits + Odd Parity + 1 Stop Bit
1	0	0	8 Bits + 2 Stop Bits
1	0	1	8 Bits + 1 Stop Bit
1	1	0	8 Bits + Even Parity + 1 Stop Bit
1	1	1	8 Bits + Odd Parity + 1 Stop Bit

Word length, Parity Select, and Stop Bit changes are not buffered and therefore become effective immediately.

Transmitter Control Bits (CR5 and CR6)

Two Transmitter Control bits provide for the control of the interrupt from the Transmit Data Register Empty condition, the Request-to-Send (RTS) output, and the transmission of a Break level (space). The following encoding format is used:

Table 4 Function of Transmitter Control-Bit

CR6	CR5	Function
0	0	RTS = "Low", Transmitting Interrupt Disabled.
0	1	RTS = "Low", Transmitting Interrupt Enabled.
1	0	RTS = "High", Transmitting Interrupt Disabled.
1	1	RTS = "Low", Transmits a Break level on the Transmit Data Output. Transmitting Interrupt Disabled.

Receive Interrupt Enable Bit (CR7)

The following interrupts will be enabled by a "1" in bit position 7 of the Control Register (CR7): Receive Data Register Full, Overrun, or a "Low" to "High" transition on the Data Carrier Detect (DCD) signal line.

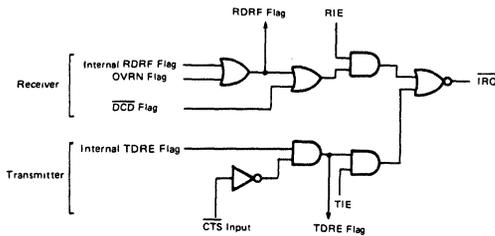


Figure 14 IRQ Internal Circuit

• Status Register

Information on the status of the ACIA is available to the MPU by reading the ACIA Status Register. This read-only register is selected when RS is "Low" and R/W is "High". Information stored in this register indicates the status of the Transmit Data Register, the Receive Data Register and error logic, and the peripheral/modem status inputs of the ACIA.

Receive Data Register Full (RDRF), Bit 0

RDRF indicates that received data has been transferred to the Receive Data Register. RDRF is cleared after an MPU read of the Receive Data Register or by a master reset. The cleared or empty state indicates that the contents of the Receive Data Register are not current. Data Carrier Detect (DCD) being "High" also causes RDRF to indicate empty.

Transmit Data Register Empty (TDRE), Bit 1

The Transmit Data Register Empty bit being set "1" indicates that the Transmit Data Register contents have been transferred and that new data may be entered. The "0" state indicates that the register is full and that transmission of a new character has not begun since the last write data command.

Data Carrier Detect (DCD), Bit 2

The DCD bit will be "1" when the DCD input from a modem has gone "High" to indicate that a carrier is not present. This bit going "1" causes an Interrupt Request to be generated when the Receive Interrupt Enable is set. It remains "1" after the DCD input is returned "Low" until cleared by first reading the Status Register and then the Data Register or until a master reset occurs. If the DCD input remains "High" after read status and read data or master reset has occurred, the interrupt is cleared, the DCD status bit remains "1" and will follow the DCD input.

Clear-to-Send (CTS), Bit 3

The CTS bit indicates the state of the CTS input from a modem. A "Low" CTS input indicates that there is a CTS from the modem. In the "High" state, the Transmit Data Register Empty bit is inhibited and the CTS status bit will be "1". Master reset does not affect the Clear-to-Send Status bit.

Framing Error (FE), Bit 4

FE flag indicates that the received character is improperly framed by a start and a stop bit and is detected by the absence of the 1st stop bit. This error indicates a synchronization error, faulty transmission, or a break condition. The FE flag is set or reset during the receive data transfer time. Therefore, this error indicator is present throughout the time that the associated character is available.

Receiver Overrun (OVRN), Bit 5

Overrun is an error flag that indicates that one or more characters in the data stream were lost. That is, a character or a number of characters were received but not read from the Receive Data Register (RDR) prior to subsequent characters being received. The overrun condition begins at the midpoint of the last bit of the second character received in succession without a read of the RDR having occurred. The overrun does not occur in the Status Register until the valid character prior to Overrun has been read. The RDRF bit remains set until the Overrun is reset. Character synchronization is maintained during the Overrun condition. The Overrun indication is reset after the reading of data from the Receive Data Register or by a Master Reset.

Parity Error (PE), Bit 6

The PE flag indicates that the number of "1"s (highs) in the character does not agree with the preselected odd or even parity. Odd parity is defined to be when the total number of ones is odd. The parity error indication will be present as long as the data character is in the RDR. If no parity is selected, then both the transmitter parity generator output and the receiver parity check results are inhibited.

Interrupt Request (IRQ), Bit 7

The IRQ bit indicates the state of the \overline{IRQ} output. Any interrupt condition with its applicable enable will be indicated in this status bit. Anytime the \overline{IRQ} output is "Low" the IRQ bit will be "1" to indicate the interrupt or service request status. IRQ is cleared by a read operation to the Receive Data Register or a write operation to the Transmit Data Register. (Refer to Figure 14.)

■ SIGNAL FUNCTIONS**● Interface Signal for MPU****Bi-Directional Data Bus ($D_0 \sim D_7$)**

The bi-directional data bus ($D_0 \sim D_7$) allow for data transfer between the ACIA and the MPU. The data bus output drivers are three-state devices that remain in the high impedance (off) state except when the MPU performs an ACIA read operation.

Enable (E)

The Enable signal, E, is a high impedance TTL compatible input that enables the bus input/output data buffers and clocks data to and from the ACIA. This signal will normally be a derivative of the HMCS6800 ϕ_2 Clock. The ACIA accepts both continuous pulse signal and strobe type signal as Enable input.

Read/Write (R/\overline{W})

The R/\overline{W} line is a high impedance input that is TTL compatible and is used to control the direction of data flow through the ACIA's input/output data bus interface. When R/\overline{W} is "High" (MPU Read cycle), ACIA output drivers are turned on and a selected register is read. When it is "Low", the ACIA output drivers are turned off and the MPU writes into a selected register. Therefore, the R/\overline{W} signal is used to select read-only or write-only registers within the ACIA.

Chip Select ($CS_0, CS_1, \overline{CS}_2$)

These three high impedance TTL compatible input lines are used to address the ACIA. The ACIA is selected when CS_0 and CS_1 are "High" and \overline{CS}_2 is "Low". Transfers of data to and from the ACIA are then performed under the control of the Enable signal, Read/Write, and Register Select.

Register Select (RS)

The RS line is a high impedance input that is TTL compatible. A "High" level is used to select the Transmit/Receive Data Registers and a "Low" level the Control/Status Registers. The R/\overline{W} signal line is used in conjunction with Register Select to select the read-only or write-only register in each register pair.

Interrupt Request (\overline{IRQ})

\overline{IRQ} is a TTL compatible, open-drain (no internal pullup), active "Low" output that is used to interrupt the MPU. The \overline{IRQ} output remains "Low" as long as the cause of the interrupt

is present and the appropriate interrupt enable within the ACIA is set.

Clock Inputs

Separate high impedance TTL compatible inputs are provided for clocking of transmitted and received data. Clock frequencies of 1, 16 or 64 times the data rate may be selected.

Transmit Clock (Tx CLK)

The Tx CLK input is used for the clocking of transmitted data. The transmitter initiates data on the negative transition of the clock.

Receive Clock (Rx CLK)

The Rx CLK input is used for synchronization of received data. (In the $\div 1$ mode, the clock and data must be synchronized externally.) The receiver samples the data on the positive transition of the clock.

● Serial Input/Output Lines**Receive Data (Rx Data)**

The Rx Data line is a high impedance TTL compatible input through which data is received in a serial format. Synchronization with a clock for detection of data is accomplished internally when clock rates of 16 or 64 times the bit rate are used. Data rates are in the range of 0 to 500 kbps when external synchronization is utilized.

Transmit Data (Tx Data)

The Tx Data output line transfers serial data to a modem or other peripheral. Data rates in the range of 0 to 500 kbps when external synchronization is utilized.

Modem Control

The ACIA includes several functions that permit limited control of a peripheral or modem. The functions included are CTS, RTS and DCD.

Clear-to-Send (\overline{CTS})

This high impedance TTL compatible input provides automatic control of the transmitting end of a communications link via the modem \overline{CTS} active "Low" output by inhibiting the Transmit Data Register Empty (TDRE) status bit. (Refer to Figure 15.)

Request-to-Send (\overline{RTS})

The \overline{RTS} output enables the MPU to control a peripheral or modem via the data bus. The \overline{RTS} output corresponds to the state of the Control Register bits CR5 and CR6. When CR6=0 or both CR5 and CR6=1, the \overline{RTS} output is "Low" (the active state). This output can also be used for Data Terminal Ready (\overline{DTR}). (Refer to Figure 15.)

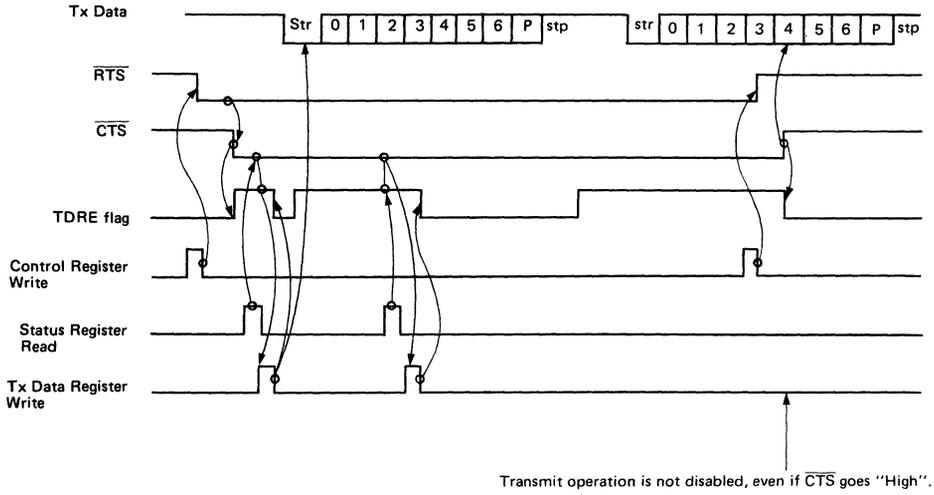


Figure 15 $\overline{\text{RTS}}$ and $\overline{\text{CTS}}$ Timing Chart (Example of 2 bytes transmission)

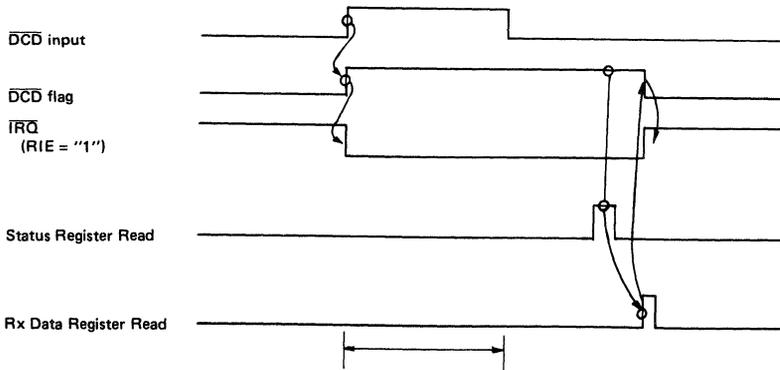
Data Carrier Detect ($\overline{\text{DCD}}$)

$\overline{\text{DCD}}$ is the input signal corresponding to the "carrier detect" signal which shows carrier detect of modem.

$\overline{\text{DCD}}$ signal is used to control the receiving operation. When $\overline{\text{DCD}}$ input goes "High", ACIA stops all the receiving operation and sets receiving part in reset status. It means that receive shift register stops shifting, error detection circuit and synchronization circuit of receive clock are reset. When $\overline{\text{DCD}}$ is in "High" level, the receiving part of ACIA is kept in initial

status and the operation in the receiving part is prohibited. When $\overline{\text{DCD}}$ goes "Low", the receiving part is allowed to receive data. In this case, the following process is needed to reset $\overline{\text{DCD}}$ flag and restarts the receive operation. (Refer to Figure 16.)

- (1) Return $\overline{\text{DCD}}$ input from "High" to "Low".
- (2) Read status register. ($\overline{\text{DCD}}$ flag = "1")
- (3) Read receive data register (Uncertain data will be read.)



All the receiving operation are prohibited and ACIA is stopped in this period.

Figure 16 $\overline{\text{DCD}}$ Flag Timing Chart

■ **Note for Use**

Input Signal, which is not necessary for user's application, should be used fixed to "High" or "Low" level. This is

applicable to the following signal pins.
Rx Data, Rx CLK, Tx CLK, $\overline{\text{CTS}}$, $\overline{\text{DCD}}$

HD6852, HD68A52

SSDA (Synchronous Serial Data Adapter)

The HD6852 Synchronous Serial Data Adapter provides a bi-directional serial interface for synchronous data information interchange. It contains interface logic for simultaneously transmitting and receiving standard synchronous communications characters in bus organized systems such as the HMCS6800 Microprocessor systems.

The bus interface of the HD6852 includes select, enable, read/write, interrupt, and bus interface logic to allow data transfer over an 8-bit bi-directional data bus. The parallel data of the bus system is serially transmitted and received by the synchronous data interface with synchronization, fill character insertion/deletion, and error checking. The functional configuration of the SSDA is programmed via the data bus during system initialization.

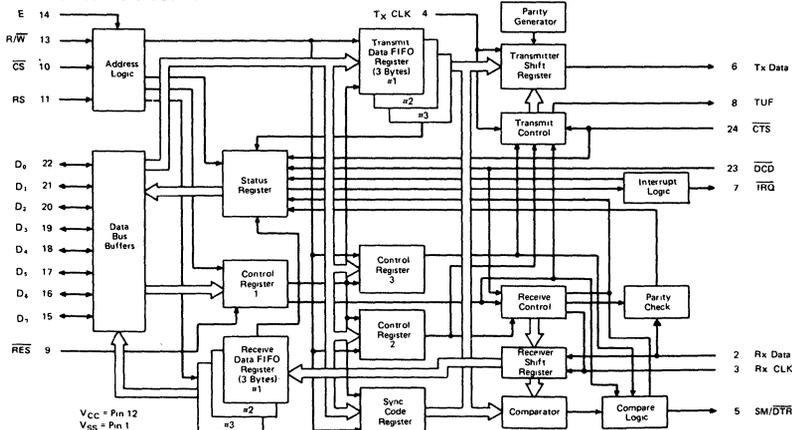
Programmable control registers provide control for variable word length, transmit control, receive control, synchronization control and interrupt control. Status, timing and control lines provide peripheral or modem control.

Typical applications include data communications terminals, floppy disk controllers, cassette or cartridge tape controllers and numerical control systems.

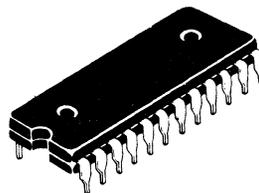
■ FEATURES

- Programmable Interrupts from Transmitter, Receiver, and Error Detection Logic
- Character Synchronization on One or Two Sync Codes
- External Synchronization Available for Parallel-Serial Operation
- Programmable Sync Code Register
- Up to 600kbps Transmitter
- Peripheral/Modem Control Functions
- Three Bytes of FIFO Buffering on Both Transmit and Receive
- 6, 7, or 8 Bit Data Transmission
- Optional Even and Odd Parity
- Parity, Overrun, and Underflow Status
- Compatible with MC6852 and MC68A52

■ BLOCK DIAGRAM

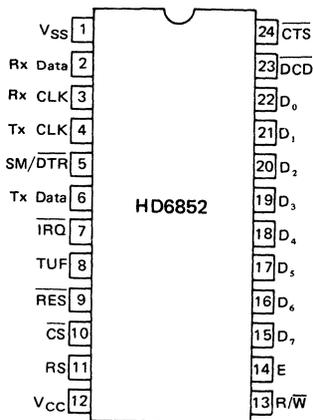


HD6852P, HD68A52P



(DP-24)

■ PIN ARRANGEMENT



(Top View)

■ ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Value	Unit
Supply Voltage	V_{CC}^*	-0.3 ~ +7.0	V
Input Voltage	V_{in}^*	-0.3 ~ +7.0	V
Operating Temperature	T_{opr}	-20 ~ +75	°C
Storage Temperature	T_{stg}	-55 ~ +150	°C

* With respect to V_{SS} (SYSTEM GND)

(NOTE) Permanent LSI damage may occur if maximum ratings are exceeded. Normal operation should be under recommended operating conditions. If these conditions are exceeded, it could affect reliability of LSI.

■ RECOMMENDED OPERATING CONDITIONS

Item	Symbol	min	typ	max	Unit
Supply Voltage	V_{CC}^*	4.75	5.0	5.25	V
Input Voltage	V_{IL}^*	-0.3	-	0.8	V
	V_{IH}^*	2.0	-	V_{CC}	V
Operating Temperature	T_{opr}	-20	25	75	°C

* With respect to V_{SS} (SYSTEM GND)

■ ELECTRICAL CHARACTERISTICS

● DC CHARACTERISTICS ($V_{CC} = 5V \pm 5\%$, $V_{SS} = 0V$, $T_a = -20 \sim +75^\circ C$, unless otherwise noted.)

Item		Symbol	Test Condition	min	typ*	max	Unit
Input "High" Voltage	All Input	V_{IH}		2.0	-	-	V
Input "Low" Voltage	All Input	V_{IL}		-0.3	-	0.8	V
Output "High" Voltage	$D_0 \sim D_7$	V_{OH}	$I_{OH} = -205 \mu A$, $PW_{EH}, PW_{EL} \leq 25 \mu s$	2.4	-	-	V
	Tx Data \overline{DTR} , TUF	V_{OH}	$I_{OH} = -100 \mu A$, $PW_{EH}, PW_{EL} \leq 25 \mu s$	2.4	-	-	V
Output "Low" Voltage	All Output	V_{OL}	$I_{OL} = 1.6 mA$, $PW_{EH}, PW_{EL} \leq 25 \mu s$	-	-	0.4	V
Input Leakage Current	TxCLK, RxCLK, Rx Data, E, \overline{RES} , RS, R/ \overline{W} , CS, DCD, CTS	I_{in}	$V_{in} = 0 \sim 5.25V$	-2.5	-	2.5	μA
Three-State Input Current (Off State)	$D_0 \sim D_7$	I_{Tsi}	$V_{in} = 0.4 \sim 2.4V$, $V_{CC} = 5.25V$	-10	-	10	μA
Output Leakage Current (Off State)	\overline{IRQ}	I_{LOH}	$V_{OH} = 2.4V$	-	-	10	μA
Power Dissipation		P_D		-	300	525	mW
Input Capacitance	$D_0 \sim D_7$	C_{in}	$V_{in} = 0V$, $T_a = 25^\circ C$, $f = 1 MHz$	-	-	12.5	pF
	RxData, RxCLK, TxCLK, \overline{RES} , CS, RS, R/ \overline{W} , E, \overline{DCD} , CTS			-	-	7.5	
Output Capacitance	TxData, \overline{DTR} , TUF,	C_{out}	$V_{in} = 0V$, $T_a = 25^\circ C$ $f = 1 MHz$	-	-	10	pF
	\overline{IRQ}			-	-	5.0	

* $T_a = 25^\circ C$, $V_{CC} = 5V$

● AC CHARACTERISTICS (V_{CC}=5V±5%, V_{SS}=0V, Ta=-20~+75°C, unless otherwise noted.)

1. TIMING OF THE DATA TRANSFER

Item	Symbol	Test Condition	HD6852			HD68A52			Unit
			min	typ	max	min	typ	max	
Clock "Low" Pulse Width	PW _{CL}	Fig. 1	700	—	—	400	—	—	ns
Clock "High" Pulse Width	PW _{CH}	Fig. 2	700	—	—	400	—	—	ns
Clock Frequency	f _C		—	—	600	—	—	1,000	kHz
Receive Data Setup Time	t _{RDSU}	Fig. 3,7	350	—	—	200	—	—	ns
Receive Data Hold Time	t _{RDH}	Fig. 3	350	—	—	200	—	—	ns
Sync Match Delay Time	t _{SM}	Fig. 3	—	—	1.0	—	—	0.666	μs
Clock-to-Data Delay for Transmitter	t _{TDD}	Fig. 4,6	—	—	1.0	—	—	0.666	μs
Transmitter Underflow	t _{TUF}	Fig. 4	—	—	1.0	—	—	0.666	μs
DTR Delay Time	t _{DTR}	Fig. 5	—	—	1.0	—	—	0.666	μs
IRQ Release Time	t _{IR}	Fig. 5	—	—	1.2	—	—	0.8	μs
RES Pulse Width	t _{RES}		1.0	—	—	0.666	—	—	μs
CTS Setup Time	t _{CTS}	Fig. 6	200	—	—	150	—	—	ns
DCD Setup Time	t _{DCD}	Fig. 7	500	—	—	350	—	—	ns
Input Rise and Fall Times(Except E)	t _r , t _f	0.8V to 2.0V	—	—	1.0*	—	—	1.0*	μs

* 1.0μ or 10% of the pulse width, whichever is smaller.

2. BUS TIMING

1) READ

Item	Symbol	Test Condition	HD6852		HD68A52		Unit
			min	max	min	max	
Enable Cycle Time	t _{cycE}	Fig. 8	1.0	—	0.666	—	μs
Enable "High" Pulse Width	PW _{EH}		0.45	25	0.28	25	μs
Enable "Low" Pulse Width	PW _{EL}		0.43	—	0.28	—	μs
Setup Time, Address and R/W valid to Enable positive transition	t _{AS}		140	—	140	—	ns
Data Delay Time	t _{DDR}		—	320	—	220	ns
Data Hold Time	t _H		10	—	10	—	ns
Address Hold Time	t _{AH}		10	80	10	80	ns
Rise and Fall Time for Enable input	t _{Er} , t _{Ef}		—	25	—	25	ns

2) WRITE

Item	Symbol	Test Condition	HD6852		HD68A52		Unit
			min	max	min	max	
Enable Cycle Time	t _{cycE}	Fig. 9	1.0	—	0.666	—	μs
Enable Pulse Width, "High"	PW _{EH}		0.45	25	0.28	25	μs
Enable Pulse Width, "Low"	PW _{EL}		0.43	—	0.28	—	μs
Setup Time, Address and R/W valid to Enable positive transition	t _{AS}		140	—	140	—	ns
Data Setup Time	t _{DSW}		195	—	80	—	ns
Data Hold Time	t _H		10	—	10	—	ns
Address Hold Time	t _{AH}		10	—	10	—	ns
Rise and Fall Time for Enable input	t _{Er} , t _{Ef}		—	25	—	25	ns

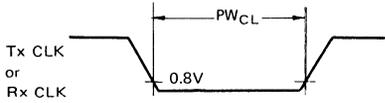


Figure 1 Clock Pulse Width ("Low" level)

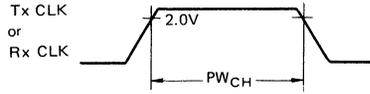


Figure 2 Clock Pulse Width ("High" level)

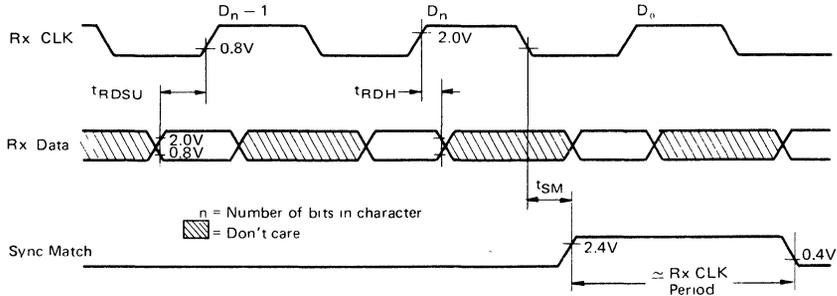


Figure 3 Receive Data Setup and Hold Times and Sync Match Delay Time

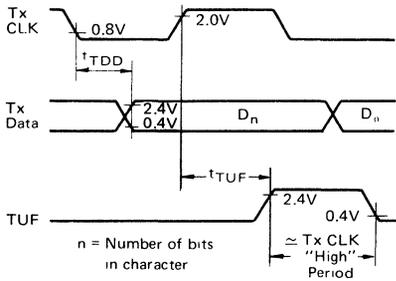
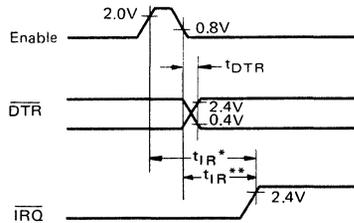


Figure 4 Transmit Data Output Delay and Transmitter Underflow Delay Time



- * $\overline{\text{IRQ}}$ Release Time applied to TxData FIFO write operation and RxData FIFO read operation.
- ** $\overline{\text{IRQ}}$ Release Time applied to write "1" operation to RxRS, TxRS, CTUF, Clear $\overline{\text{CTS}}$ bits.

Figure 5 $\overline{\text{DTR}}$ and $\overline{\text{IRQ}}$ Release Time

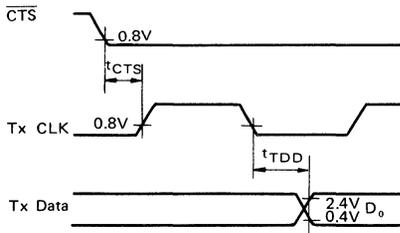
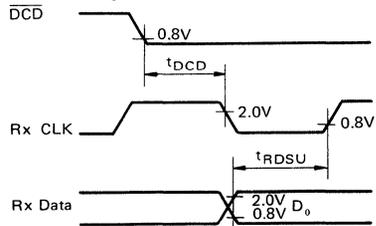


Figure 6 $\overline{\text{CTS}}$ Setup Time



At least two Rx CLK pulse should be input after the last bit of the last data before the next falling edge of DCD occurs.

Figure 7 $\overline{\text{DCD}}$ Setup Time

- **Initialization**

During a power-on sequence, the SSDA is reset via the $\overline{\text{RES}}$ input and internally latched in a reset condition to prevent erroneous output transmissions. The Sync Code Register, Control Register 2, and Control Register 3 should be programmed prior to the programmed release of the Transmitter and/or Receiver Reset bits; these bits in Control Register 1 should be cleared after the RES line has gone "High".

- **Transmitter Operation**

Data is transferred to the transmitter section in parallel form by means of the data bus and Transmit Data FIFO. The Transmit Data FIFO is a 3-byte register whose status is indicated by the Transmitter Data Register Available status bit (TDRA) and its associated interrupt enable bit. Data is transferred through the FIFO on negative edges of Enable (E) pulses. Two data transfer modes are provided in the SSDA. The 1-byte transfer mode provides for writing data to the transmitter section (and reading from the receiver section) one byte at a time. The 2-byte transfer mode provides for writing two data characters in succession.

Data will automatically transfer from the last register location in the Transmit Data FIFO (when it contains data) to the Transmitter Shift Register during the last half of the last bit of the previous character. A character is transferred into the Shift Register by the Transmitter Clock. Data is transmitted LSB first, and odd or even parity can be optionally appended. The unused bit positions in short word length characters from the data bus are "don't cares". (Note: The data bus inputs may be reversed for applications requiring the MSB to be transferred taken, e.g., IBM format for floppy disks; however, care must be taken to properly program the control registers – Table 1 will have its bit positions reversed.)

When the Shift Register becomes empty, and data is not available for transfer from the Transmit Data FIFO, an "underflow" occurs, and a character is inserted into the transmitter data stream to maintain character synchronization. The character transmitted on underflow will be either a "Mark" (all "1"s) or the contents of the Sync Code Register, depending upon the state of the Transmit Sync Code on Underflow control bit. The underflow condition is indicated by a pulse (\approx Tx CLK "High" period) on the Underflow output (when in Tx Sync on underflow mode). The Underflow output occurs coincident with the transfer of the last half of the last bit preceding the underflow character. The Underflow status bit is set until cleared by means of the Clear Underflow control bit. This output may be used in floppy disk systems to synchronize write operations and for appending CRCC.

Transmission is initiated by clearing the Transmitter Reset bit in Control Register 1. When the Transmitter Reset bit is cleared, the first full positive half-cycle of the Transmit Clock will initiate the transmit cycle, with the transmission of data or underflow characters beginning on the negative edge of the Transmit Clock pulse which started the cycle. If the Transmit Data FIFO was not loaded, an underflow character will be transmitted.

The Clear-to-Send ($\overline{\text{CTS}}$) input provides for automatic control of the transmitter by means of external system hardware; e.g., the modem $\overline{\text{CTS}}$ output provides the control in a data communications system. The $\overline{\text{CTS}}$ input resets and inhibits the transmitter section when "High", but does not reset the Transmit Data FIFO. The TDRA status bit is inhibited by $\overline{\text{CTS}}$ being "High" in either the one-sync character or two-sync-character mode of operation.

In the external sync mode, TDRA is unaffected by $\overline{\text{CTS}}$ in order to provide Transmit Data FIFO status for preloading and operating the transmitter under the control of the $\overline{\text{CTS}}$ input. When the Transmitter Reset bit (Tx Rs) is set, the Transmit Data FIFO is cleared and the TDRA status bit is cleared. After one E clock has occurred, the Transmit Data FIFO becomes available for new data with TDRA inhibited.

- **Receiver Operation**

Data and a presynchronized clock are provided to the SSDA receiver section by means of the Receive Data (Rx Data) and Receive Clock (Rx CLK) inputs. The data is a continuous stream of binary data bits without means for identifying character boundaries within the stream. It is, therefore, necessary to achieve character synchronization for the data at the beginning of the data block. Once synchronization is achieved, it is assumed to be retained for all successive characters within the block.

Data communications systems utilize the detection of sync codes during the initial portion of the preamble to establish character synchronization. This requires the detection of a single code or two successive sync codes. Floppy disk and cartridge tape units require sixteen bits of defined preamble and cassettes require eight bits of preamble to establish the reference for the start of record. All three are functionally equivalent to the detection of sync codes. Systems which do not utilize code detection techniques require custom logic external to the SSDA for character synchronization and use of the parallel-to-serial (external sync) mode.

(Note: The Receiver Shift Register is set to ones when reset)

- **Synchronization**

The SSDA provides three operating modes with respect to character synchronization: one-sync-character mode, two-sync-character mode, and external sync mode. The external sync mode requires synchronization and control of the receiving section through the Data Carrier Detect ($\overline{\text{DCD}}$) input. This external synchronization could consist of direct line control from the transmitting end of the serial data link or from external logic designed to detect the start of the message block. The one-sync-character mode searches on a bit-by-bit basis until a match is achieved between the data in the Shift Register and the Sync Code Register. The match indicates character synchronization is complete and will be retained for the message block. In the two-sync-character mode, the receiver searches for the first sync code match on a bit-by-bit basis and then looks for a second successive sync code character prior to establishing character synchronization. If the second sync code character is not received, the bit-by-bit search for the first sync code is resumed.

Sync codes received prior to the completion of synchronization (one or two character) are not transferred to the Receive Data FIFO. Redundant sync codes during the preamble or sync codes which occur as "fill characters" can automatically be stripped from the data, when the Strip Sync control bit is set, to minimize system loading. The character synchronization will be retained until cleared by means of the Clear Sync bit, which also inhibits synchronization search when set.

- **Receiving Data**

Once synchronization has been achieved, subsequent characters are automatically transferred into the Receive Data FIFO and clocked through the FIFO to the last empty location by E pulses (MPU System ϕ 2). The Receiver Data Available status bit

(RDA) indicates when data is available to be read from the last FIFO location (#3) when in the 1-byte transfer mode. The 2-byte transfer mode causes the RDA status bit to indicate data is available when the last two FIFO register locations are full. Data being available in the Receive Data FIFO causes an interrupt request if the Receiver Interrupt Enable (RIE) bit is set. The MPU will then read the SSDA Status Register, which will indicate that data is available for the MPU read from the Receiver Data FIFO register. The \overline{IRQ} and RDA status bits are reset by a read from the FIFO. If more than one character has been received and is resident in the Receive Data FIFO, subsequent E clocks will cause the FIFO to update and the RDA and \overline{IRQ} status bits will again be set. The read data operation for the 2-byte transfer mode requires an intervening E clock between reads to allow the FIFO data to shift. Optional parity is automatically checked as data is received, and the parity status condition is maintained with each character until the data is read from the Receive Data FIFO. Parity errors will cause an interrupt request if the Error Interrupt Enable (EIE) has been set. The parity bit is not transferred to the data bus but must be checked in the Status Register. NOTE: In the 2-byte transfer mode, parity should be checked prior to reading the second byte, since a FIFO read clears the error bit.

Other status bits which pertain to the receiver section are Receiver Overrun and Data Carrier Detect (\overline{DCD}). The Overrun status bit is automatically set when a transfer of a character to the Receive Data FIFO occurs and the first register of the Receive Data FIFO is full. Overrun causes an interrupt if Error Interrupt Enable (EIE) has been set. The transfer of the overrunning character into the FIFO causes the previous character in the FIFO input register location to be lost. The Overrun status bit is cleared by reading the Status Register (when the overrun condition is present), followed by a Receive Data FIFO Register read. Overrun cannot occur and be cleared without providing an opportunity to detect its occurrence via the Status Register.

A positive transition on the \overline{DCD} input causes an interrupt if the EIE control bit has been set. The interrupt caused by \overline{DCD} is cleared by reading the Status Register when the \overline{DCD} status bit is "1", followed by a Receive Data FIFO read. The \overline{DCD} status bit will subsequently follow the state of the \overline{DCD} input when it goes "Low".

■ SSDA REGISTERS

Seven registers in the SSDA can be accessed by means of the bus. The registers are defined as read-only or write-only according to the direction of information flow. The Register Select (RS) input selects two registers in each state, one being read-only and the other write-only. The Read/Write (R/ \overline{W}) input defined which of the two selected registers will actually be accessed. Four registers (two read-only and two write-only) can be addressed via the bus at any particular time. These registers and the required addressing are defined in Table 1.

● Control Register 1 (C1)

Control Register 1 is an 8-bit write-only register that can be directly addressed from the data bus. Control Register 1 is addressed when RS = "Low" and R/ \overline{W} = "Low".

Receiver Reset (Rx Rs), C1 Bit 0

The Receiver Reset control bit provides both a reset and inhibit function to the receiver section. When Rx Rs is set, it clears the receiver control logic, error logic, Rx Data FIFO

Control, Parity Error status bit, and \overline{DCD} interrupt. The Receiver Shift Register is set ones. The Rx Rs bit must be cleared after the occurrence of a "Low" level on \overline{RES} in order to enable the receiver section of the SSDA.

Transmitter Reset (Tx Rs), C1 Bit 1

The Transmitter Reset control bit provides both a reset and inhibit to the transmitter section. When Tx Rs is set, it clears the transmitter control section, Transmitter Shift Register, Tx Data FIFO Control (the Tx Data FIFO can be reloaded after one E clock pulse), the Transmitter Underflow status bit, and the \overline{CTS} interrupt, and inhibits the TDRA status bit (in the one-sync-character and two-sync-character modes). The Tx Rs bit must be cleared after the occurrence of a "Low" level on \overline{RES} in order to enable the transmitter section of the SSDA. If the Tx FIFO is not preloaded, it must be loaded immediately after the Tx Rs release to prevent a transmitter underflow condition.

Strip Synchronization Characters (Strip Sync), C1 Bit 2

If the Strip Sync bit is set, the SSDA will automatically strip all received characters which match the contents of the Sync Code Register. The characters used for synchronization (one or two characters of sync) are always stripped from the received data stream.

Clear Synchronization (Clear Sync), C1 Bit 3

The Clear Sync control bit provides the capability of dropping receiver character synchronization and inhibiting resynchronization. The Clear Sync bit is set to clear and inhibit receiver synchronization in all modes and is reset to zero to enable resynchronization.

Transmitter Interrupt Enable (TIE), C1 Bit 4

TIE enable both the Interrupt Request (\overline{IRQ}) output and Interrupt Request status bit to indicate a transmitter service request. When TIE is set and the TDRA status bit is "1", the \overline{IRQ} output will go "Low" (the active state) and the \overline{IRQ} status bit will go "1".

Receiver Interrupt Enable (RIE), C1 Bit 5

RIE enable both the Interrupt Request output (\overline{IRQ}) and the Interrupt Request status bit to indicate a receiver service request. When RIE is set and the RDA status bit is "1", the \overline{IRQ} output will go "Low" (the active state) and the \overline{IRQ} status bit will go "1".

Address Control 1 (AC1) and Address Control 2 (AC2), C1 Bits 6 and 7

AC1 and AC2 select one of the write-only registers – Control 2, Control 3, Sync Code, or Tx Data FIFO – as shown in Table 1, when RS = "High" and R/ \overline{W} = "Low".

● Control Register 2 (C2)

Control Register 2 is an 8-bit write-only register which can be programmed from the bus when the Address Control bits in Control Register 1 (AC1 and AC2) are reset, RS = "High" and R/ \overline{W} = "Low".

Peripheral Control 1 (PC1) and Peripheral Control 2 (PC2), C2 Bits 0 and 1

Two control bits, PC1 and PC2, determine the operating characteristics of the Sync Match/ \overline{DTR} output. PC1, when "High", selects the Sync Match mode. PC2 provides the inhibit/

enable control for the SM/ $\overline{\text{DTR}}$ output in the Sync Match mode. A one-bit-wide pulse is generated at the output when PC2 is "0", and a match occurs between the contents of the Sync Code Register and the incoming data even if sync is inhibited (Clear Sync bit = "1"). The Sync Match pulse is referenced to the negative edge of Rx CLK pulse causing the match.

The Data Terminal Ready ($\overline{\text{DTR}}$) mode is selected when PC1 is "0". When PC2 = "1" the SM/ $\overline{\text{DTR}}$ output = "Low" and vice versa. The operation of PC2 and PC1 is summarized in Table 4.

1-Byte/2-Byte Transfer (1-Byte/2-Byte), C2 Bit 2

When 1-Byte/2-Byte is set, the TDRA and RDA status bits will indicate the availability if their respective data FIFO registers for a single byte data transfer. Alternately, if 1-Byte/2-Byte is reset, the TDRA and RDA status bits indicate when two bytes of data can be moved without a second status read. An intervening Enable pulse must occur between data transfers.

Word Length Selects (WS1, WS2, WS3), C2 Bits 3, 4, 5

Word length Select bits WS1, WS2, and WS3 select word length of 7, 8, or 9 bits including parity as shown in Table 3.

Transmit Sync Code on Underflow (Tx Sync), C2 Bit 6

When Tx Sync is set, the transmitter will automatically send a sync character when data is not available for transmission. If Tx Sync is reset, the transmitter will transmit a Mark character (including the parity bit position) on underflow. When the underflow is detected, a pulse approximately a Tx CLK "High" period wide will occur on the underflow output if the Tx Sync bit is "1". Internal parity generation is inhibited during underflow except for sync code fill character transmission in 8 bit plus parity word lengths.

Error Interrupt Enable (EIE), C2 Bit 7

When EIE is set, the $\overline{\text{IRQ}}$ status bit will go "1" and the $\overline{\text{IRQ}}$ output will go "Low" if:

- 1) A receiver overrun occurs. The interrupt is cleared by reading the Status Register and reading the Rx Data FIFO.
- 2) $\overline{\text{DCD}}$ input has gone to a "High". The interrupt is cleared by reading the Status Register and reading the Rx Data FIFO.
- 3) A parity error exists for the character in the last location (#3) of the Rx Data FIFO. The interrupt is cleared by reading the Rx Data FIFO. The interrupt is cleared by reading the Rx Data FIFO.
- 4) The $\overline{\text{CTS}}$ input has gone to a "High". The interrupt is cleared by writing a "1" in the Clear $\overline{\text{CTS}}$ bit, C3 bit 2, or by a Tx Reset.
- 5) The transmitter has underflowed (in the Tx Sync on Underflow mode). The interrupt is cleared by writing a "1" into the Clear Underflow, C3 bit 3, or Tx Reset.

When EIE is a "0", the $\overline{\text{IRQ}}$ status bit and the $\overline{\text{IRQ}}$ output are disabled for the above error conditions. A "Low" level on the RES input resets EIE to "0".

Control Register 3 (C3)

Control Register 3 is a 4-bit write-only register which can be programmed from the bus when RS = "High" and $\text{R}/\overline{\text{W}}$ = "Low" and Address Control bit AC1 = "1" and AC2 = "0".

External/Internal Sync Mode Control (E/I Sync), C3 Bit 0

When the E/I Sync Mode bit is "1", the SSSA is in the external sync mode and the receiver synchronization logic is disabled. Synchronization can be achieved by means of the $\overline{\text{DCD}}$ input or by starting Rx CLK at the midpoint of data bit "0" of

a character with $\overline{\text{DCD}}$ "Low". Both the transmitter and receiver sections operate as parallel – serial converters in the External Sync mode. The Clear Sync bit in Control Register 1 acts as a receiver sync inhibit when "High" to provide a bus controllable inhibit. The Sync Code Register can serve as a transmitter fill character register and a receiver match register in this mode. A "Low" on the $\overline{\text{RES}}$ input resets the E/I Sync Mode bit placing the SSSA in the internal sync mode.

One-Sync-Character/Two-Sync-Character Mode, Control 1 Sync/2 Sync, C3 Bit 1

When the 1 Sync/2 Sync bit is set, the SSSA will synchronize on a single match between the received data and the contents of the Sync Code Register. When the 1 Sync/2 Sync bit is reset, two successive sync characters must be received prior to receiver synchronization. If the second sync character is not detected, the bit by bit search resumes from the first bit in the second character. See the description of the Sync Code Register for more details.

Clear $\overline{\text{CTS}}$ Status (Clear $\overline{\text{CTS}}$), C3 Bit 2

When a "1" is written into the Clear $\overline{\text{CTS}}$ bit, the stored status and interrupt are cleared. Subsequently, the $\overline{\text{CTS}}$ status bit reflects the state of the $\overline{\text{CTS}}$ input. The Clear $\overline{\text{CTS}}$ control bit does not affect the $\overline{\text{CTS}}$ input nor its inhibit of the transmitter section. The Clear $\overline{\text{CTS}}$ command bit is self-clearing, and writing a "0" into this bit is a nonfunctional operation.

Clear Transmit Underflow Status (CTUF), C3 Bit 3

When a "1" is written into the CTUF status bit, the CTUF bit and its associated interrupt are reset. The CTUF command bit is self-clearing and writing a "0" into this bit is a nonfunctional operation.

Sync Code Register

The Sync Code Register is an 8-bit register for storing the programmable sync code required for received data character synchronization in the one-sync-character and two-sync-character modes. The Sync Code Register also provides for stripping the sync/fill characters from the received data (a programmable option) as well as automatic insertion of fill characters in the transmitted data stream. The Sync Code Register is not utilized for receiver character synchronization in the external sync mode; however, it provides storage of receiver match and transmit fill characters.

The Sync Code Register can be loaded when AC2 and AC1 are a "1" and "0" respectively, and $\text{R}/\overline{\text{W}}$ = "Low" and RS = "High".

The Sync Code Register may be changed after the detection of a match with the received data (the first sync code having been detected) to synchronize with a double-word sync pattern. (This sync code change must occur prior to the completion of the second character.) The sync match (SM) output can be used to interrupt the MPU system to indicate that the first eight bits have matched. The service routine would then change the sync match register to the second half of the pattern. Alternately, the one-sync-character mode can be used for sync codes for 16 or more bits by using software to check the second and subsequent bytes after reading them from the FIFO.

The detection of the sync code can be programmed to appear on the Sync Match/ $\overline{\text{DTR}}$ output by writing a "1" in PC1 (C2 bit 0) and a "0" in PC2 (C2 bit 1). The Sync Match output will go "High" for one bit time beginning at the character interface between the sync code and the next character.

● **Parity for Sync Character**

Transmitter

Transmitter does not generate parity for the sync character except 9-bit mode.

- 9-bit (8-bit + parity) – 8-bit sync character + parity
- 8-bit (7-bit + parity) – 8-bit sync character (no parity)
- 7-bit (6-bit + parity) – 7-bit sync character (no parity)

Receiver

At Synchronization

Receiver automatically strips the sync character(s) (two sync characters if '2 sync' mode is selected) which is used to establish synchronization. And parity is not checked for these sync characters.

After Synchronization is Established

When 'strip sync' bit is selected, the sync characters (fill characters) are stripped and parity is not checked for the stripped sync (fill) characters. When 'strip sync' bit is not selected (0), the sync character is assumed to be normal data and it is transferred into FIFO after parity checking. (When non-parity format is selected, parity is not checked.)

Strip Sync (C1 Bit 2)	Data Format (C2 Bit 3-5)	Operation
1	x	No transfer of sync code. No parity check of sync code.
0	With Parity	*Transfer data and sync codes. Parity check.
0	Without Parity	*Transfer data and sync codes. No parity check.

* Subsequent to synchronization
x don't care

It is necessary to pay attention to the selected sync character in the following cases.

- 1) Data format is (6 + parity), (7 + parity),
- 2) Strip sync is not selected ("0").
- 3) After synchronization when sync code is used as a fill character.

Transmitter sends sync character without parity, but receiver checks the parity as if it is normal data. Therefore, the sync character should be chosen to match the parity check selected for the receiver in this special case.

● **Receive Data First-In First-Out Register (Rx Data FIFO)**

The Receive Data FIFO Register consists of three 8-bit registers which are used for buffer storage of received data. Each 8-bit register has an internal status bit which monitors its full or empty condition. Data is always transferred from a full register to an adjacent empty register. The transfer from register to register occurs on E pulses. The RDA status bit will be "1" when data is available in the last location of the Rx Data FIFO.

In an Overrun condition, the overrunning character will be transferred into the full first stage of the FIFO register and will cause the loss of that data character. Successive overruns continue to overwrite the first register of the FIFO. This destruction of data is indicated by means of the Overrun status

bit. The Overrun bit will be set when the overrun occurs and remains set until the Status Register is read, followed by a read of the Rx Data FIFO.

Unused data bits for short word lengths (including the parity bit) will appear as "0"s on the data bus when the Rx Data FIFO is read.

● **Transmit Data First-In First-Out Register (Tx Data FIFO)**

The Transmit Data FIFO Register consists of three 8-bit registers which are used for buffer storage of data to be transmitted. Each 8-bit register has an internal status bit which monitors its full or empty condition. Data is always transferred from a full register to an adjacent empty register. The transfer is clocked by E pulses.

The TDRA status bit will be "High" if the Tx Data FIFO is available for data.

Unused data bits for short word lengths will be handled as "don't cares". The parity bit is not transferred over the data bus since the SSSA generates parity at transmission.

When an Underflow occurs, the Underflow character will be either the contents of the Sync Code Register or an all "1"s character. The underflow will be stored in the Status Register until cleared and will appear on the Underflow output as a pulse approximately a Tx CLK "High" period wide.

● **Status Register**

The Status Register is an 8-bit read-only register which provides the real-time status of the SSSA and the associated serial data channel. Reading the Status Register is a non-destructive process. The method of clearing status bits depends upon the function each bit represents and is discussed for each bit in the register.

Receiver Data Available (RDA), S Bit 0

The Receiver Data Available status bit indicates when receiver data can be read from the Rx Data FIFO. The receiver data being present in the last register (#3) of the FIFO causes RDA to be "1" for the 1-byte transfer mode. The RDA bit being "1" indicates that the last two registers (#2 and #3) are full when in the 2-byte transfer mode. The second character can be read without a second status read (to determine that the character is available). And E pulse must occur between reads of the Rx Data FIFO to allow the FIFO to shift. Status must be read on a word-by-word basis if receiver data error checking is important. The RDA status bit is reset automatically when data is not available.

Transmitter Data Register Available (TDRA), S Bit 1

The TDRA status bit indicates that data can be loaded into the Tx Data FIFO Register. The first register (#1) of the Tx Data FIFO being empty will be indicated by a "1" in the TDRA status bit in the 1-byte transfer mode. The first two registers (#1 and #2) must be empty for TDRA to be "1" when in the 2-byte transfer mode. The Tx Data FIFO can be loaded with two bytes without an intervening status read; however, one E pulse must occur between loads. TDRA is inhibited by the Tx Reset or $\overline{\text{RES}}$. When Tx Reset is set, the Tx Data FIFO is cleared and then released on the next E clock pulse. The Tx Data FIFO can then be loaded with up to three characters of data, even though TDRA is inhibited. This feature allows preloading data prior to the release of Tx Reset. A "High" level on the $\overline{\text{CTS}}$ input inhibits the TDRA status bit in either sync mode of operation (one-sync-character or two-sync-character). $\overline{\text{CTS}}$ does not affect TDRA in the external sync mode. This

enables the SSDA to operate under the control of the \overline{CTS} input with TDRA indicating the status of the Tx Data FIFO. The \overline{CTS} input does not clear the Tx Data FIFO in any operating mode.

Data Carrier Detect (\overline{DCD}), S Bit 2

A positive transition on the \overline{DCD} input is stored in the SSDA until cleared by reading both Status and Rx Data FIFO. A "1" written into Rx Rs also clears the stored \overline{DCD} status. The \overline{DCD} status bit, when set, indicates that the \overline{DCD} input has gone "High". The reading of both Status and Receive Data FIFO allows Bit 2 of subsequent Status reads to indicate the state of the \overline{DCD} input until the next positive transition.

Clear-to-Send (\overline{CTS}), S Bit 3

A positive transition on the \overline{CTS} input is stored in the SSDA until cleared by writing a "1" into the Clear \overline{CTS} control bit or the Tx Rs bit. The \overline{CTS} status bit, when set, indicates that the \overline{CTS} input has gone "High". The Clear \overline{CTS} command (a "1" into C3 Bit 2) allows Bit 3 of subsequent Status reads to indicate the state of the \overline{CTS} input until the next positive transition.

Transmitter Underflow (TUF), S Bit 4

When data is not available for the transmitter, an underflow occurs and is so indicated in the Status Register (in the Tx Sync on underflow mode). The underflow status bit is cleared by writing a "1" into the Clear Underflow (CTUF) control bit or

the Tx Rs bit. TUF indicates that a sync character will be transmitted as the next character. A TUF is indicated on the output only when the contents of the Sync Code Register is to be transferred (transmit sync code on underflow = "1").

Receiver Overrun (Rx Ovrn), S Bit 5

Overrun indicates data has been received when the Rx Data FIFO is full, resulting in data loss. The Rx Ovrn status bit is set when Overrun occurs. The Rx Ovrn status bit is cleared by reading Status followed by reading the Rx Data FIFO or by setting the Rx Rs control bit.

Receiver Parity Error (PE), S Bit 6

The parity error status bit indicates that parity for the character in the last register of the Rx Data FIFO did not agree with selected parity. The parity error is cleared when the character to which it pertains is read from the Rx Data FIFO or when Rx Rs occurs. The \overline{DCD} input does not clear the Parity Error or Rx Data FIFO status bits.

Interrupt Request (\overline{IRQ}), S Bit 7

The Interrupt Request status bit indicates when the \overline{IRQ} output is in the active state (\overline{IRQ} output = "Low"). The IRQ status bit is subject to the same interrupt enables (RIE, TIE, and EIE) as the \overline{IRQ} output. The IRQ status bit simplifies status inquiries for polling systems by providing single bit indication of service requests.

Table 1 SSDA Programming Model

Register	Control* Inputs		Address Control		Register Content							
	RS	R/W	AC2	AC1	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Status (S)	0	1	X	X	Interrupt Request (\overline{IRQ})	Receiver Parity Error (PE)	Receiver Overrun (Rx Ovrn)	Transmitter Underflow (TUF)	Clear-to-Send (\overline{CTS})	Data Carrier Detect (\overline{DCD})	Transmitter Data Register Available (TDRA)	Receiver Data Available (RDA)
Control 1 (C1)	0	0	X	X	Address Control 2 (AC2)	Address Control 1 (AC1)	Receiver Interrupt Enable (RIE)	Transmitter Interrupt Enable (TIE)	Clear Sync	Strip Sync Characters (Strip Sync)	Transmitter Reset (Tx Rs)	Receiver Reset (Rx Rs)
*** Receive Data FIFO	1	1	X	X	D ₇	D ₆	D ₅	D ₄	D ₃	D ₂	D ₁	D ₀
Control 2 (C2)	1	0	0	0	Error Interrupt Enable (EIE)	Transmit Sync Code on Underflow (Tx Sync)	Word Length Select 3 (WS3)	Word Length Select 2 (WS2)	Word Length Select 1 (WS1)	1-Byte/2-Byte Transfer (1-Byte/2-Byte)	Peripheral Control 2 (PC2)	Peripheral Control 1 (PC1)
Control 3 (C3)	1	0	0	1	Not Used	Not Used	Not Used	Not Used	Clear Transmitter Underflow Status (CTUF)	Clear \overline{CTS} Status (Clear \overline{CTS})	One-Sync-Character/Two-Sync Character Mode Control (1 Sync/2 Sync)	External/Internal Sync Mode Control (E/I Sync)
** Sync Code	1	0	1	0	D ₇	D ₆	D ₅	D ₄	D ₃	D ₂	D ₁	D ₀
*** Transmit Data FIFO	1	0	1	1	D ₇	D ₆	D ₅	D ₄	D ₃	D ₂	D ₁	D ₀

* 0: "Low" level, 1: "High" level

** "FF" should not be used as Sync Code.

*** When the SSDA is used in applications requiring the MSB of data to be receive and transmitted first, the data bus inputs to the SSDA may be reversed (D₀ to D₇, etc.). Caution must be used when this is done since the bit positions in this table will be reversed, and the parity should not be selected.

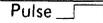
Table 2 Functions of SSSA Register

Register	Bit	Symbol	Function			
Status Register (S)	7	IRQ	The IRQ flag is cleared when the source of the IRQ is cleared. The source is determined by the enables in the Control Registers: TIE, RIE, EIE.			
	6	PE	Conditions for Set	Conditions for Reset		
	5	Rx Ovrn			When parity error is detected in receive data.	Read Rx Data FIFO, or a "1" into Rx Rs (C1 Bit 0).
	4	TUF			When receive data FIFO overruns.	Read Status and then Rx Data FIFO, or a "1" into Rx Rs (C1 Bit 0).
	3	CTS			When under flow is occurred in the transmitter.	A "1" into CTUF (C3 Bit 3) or into Tx Rs (C1 Bit 1).
	2	DCD			When CTS signal rises.	A "1" into Clear CTS (C3 Bit 2) or a "1" into Tx Rs (C1 Bit 1)
	1	TDRA			When DCD signal rises.	Read Status and then Rx Data FIFO or a "1" into Rx Rs (C1 Bit 0)
	0	RDA			1 Byte Transfer Mode; when the transmit data FIFO (#1) is empty.	Write into Tx Data FIFO.
2 Byte Transfer Mode; when the transmit data FIFO (#1, #2) is empty.						
Control Register 1 (C1)	7	AC2	Used to access other registers, as shown Table 1.			
	6	AC1				
	5	RIE			When "1", enables interrupt on RDA (S Bit 0).	
	4	TIE			When "1", enables interrupt on TDRA (S Bit 1).	
	3	Clear Sync			When "1", clears receiver character synchronization.	
	2	Strip Sync			When "1", strips all sync codes from the received data stream.	
	1	Tx Rs			When "1", resets and inhibits the transmitter section.	
	0	Rx Rs			When "1", resets and inhibits the receiver section.	
Control Register 2 (C2)	7	EIE	When "1", enables the PE, Rx Ovrn, TUF, CTS, and DCD interrupt flags (S Bits 6 through 2).			
	6	Tx Sync	When "1", allows sync code contents to be transferred on underflow, and enables the TUF Status bit and output. When "0", an all mark character is transmitted on underflow.			
	5	WS3	Word Length Select			
	4	WS2				
	3	WS1				
	2	1-Byte/2-Byte	When "1", enables the TDRA and RDA bits to indicate when a 1-byte transfer can occur; when "0", the TDRA and RDA bits indicate when a 2-byte transfer can occur.			
1	PC2	SM/DTR Output Control				
0	PC1					
Control Register 3 (C3)	3	CTUF	When "1", clears TUF (S Bit 4), and IRQ if enabled.			
	2	Clear CTS	When "1", clears CTS (S Bit 3), and IRQ if enabled.			
	1	1-Sync/2-Sync	When "1", selects the one-sync-character mode; when "0", selects the two-sync-character mode.			
	0	E/I Sync	When "1", selects the external sync mode; when "0", selects the internal sync mode.			

Table 3 Word Length

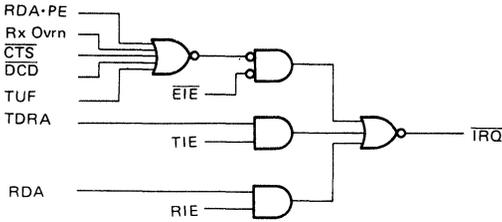
Bit 5 WS3	Bit 4 WS2	Bit 3 WS1	Word Length
0	0	0	6 Bits + Even Parity
0	0	1	6 Bits + Odd Parity
0	1	0	7 Bits
0	1	1	8 Bits
1	0	0	7 Bits + Even Parity
1	0	1	7 Bits + Odd Parity
1	1	0	8 Bits + Even Parity
1	1	1	8 Bits + Odd Parity

Table 4 SM/DTR Output Control

Bit 1 PC2	Bit 0 PC1	SM/DTR Output at Pin 5
0	0	"High" Level*
0	1	Pulse  1-Bit Wide, on SM
1	0	"Low" Level*
1	1	SM Inhibited, "Low" **

* OUTPUT level is fixed by the data written into PC2, PC1.

** When "10" or "11", output is fixed at "Low".



■ INTERFACE SIGNALS FOR MPU

The SSDA interfaces to the HD6800 MPU with an 8-bit bi-directional data bus, a chip select line, a register select line, an interrupt request line, read/write line, an enable line, and a reset line. These signals, in conjunction with the HD6800 VMA output, permit the MPU to have complete control over the SSDA.

● Bi-Directional Data Bus ($D_0 \sim D_7$)

The bi-directional data bus ($D_0 \sim D_7$) allow for data transfer between the SSDA and the MPU. The data bus output drivers are three-state devices that remain in the high impedance (off) state except when the MPU performs an SSDA read operation.

● Enable (E)

The Enable signal, E, is a high impedance TTL compatible input that enables the bus input/output data buffers, clocks data to and from the SSDA, and moves data through the FIFO Registers. This signal is normally the continuous HMCS6800 System $\phi 2$ clock, so that incoming data characters are shifted through the FIFO.

● Read/Write (R/\bar{W})

The Read/Write line is a high impedance input that is TTL compatible and is used to control the direction of data flow through the SSDA's input/output data bus interface. When Read/Write is "High" (MPU read cycle), SSDA output drivers are turned on if the chip is selected and a selected register is read. When it is "Low", the SSDA output drivers are turned off and the MPU writes into a selected register. The Read/Write signal is also used to select read-only or write-only registers within the SSDA.

● Chip Select (\bar{CS})

This high impedance TTL compatible input line is used to address the SSDA. The SSDA is selected when \bar{CS} is "Low". VMA should be used in generating the \bar{CS} input to insure that false selects will not occur. Transfers of data to and from the SSDA are then performed under the control of the Enable signal, Read/Write, and Register Select.

● Register Select (RS)

The Register Select line is a high impedance input that is TTL compatible. A "High" level is used to select Control Registers C2 and C3, the Sync Code Register, and the Transmit/Receive Data Registers. A "Low" level selects the Control 1 and Status Registers (see Table 1).

● Interrupt Request (\bar{IRQ})

\bar{IRQ} is a TTL compatible, open-drain (no internal pullup), active "Low" output that is used to interrupt the MPU. The \bar{IRQ} remains "Low" until cleared by the MPU.

● Reset (\bar{RES})

The \bar{RES} input provides a means of resetting the SSDA from an external source. In the "Low" state, the \bar{RES} input causes the following:

- 1) Receiver Reset (Rx Rs) and Transmitter Reset (Tx Rs) bits are set causing both the receiver and transmitter sections to be held in a reset condition.
- 2) Peripheral Control bits PC1 and PC2 are reset to zero, causing the SM/DTR output to be "High".
- 3) The Error Interrupt Enable (EIE) bit is reset.
- 4) An internal synchronization mode is selected.
- 5) The Transmitter Data Register Available (TDRA) status bit is cleared and inhibited.

When \bar{RES} returns "High" (the inactive state), the transmitter and receiver sections will remain in the reset state until the Receiver Reset and Transmitter Reset bits are cleared via the bus under software control. The control Register bits affected by \bar{RES} (Rx Rs, Tx Rs, PC1, PC2, EIE, and E/I Sync) cannot be changed when \bar{RES} is "Low".

■ CLOCK INPUTS

Separate high impedance TTL compatible inputs are provided for clocking of transmitted and received data.

● Transmit Clock (Tx CLK)

The Transmit Clock input is used for the clocking of transmitted data. The transmitter shifts data on the negative transition of the clock.

● Receive Clock (Rx CLK)

The Receive Clock input is used for clocking in received data. The clock and data must be synchronized externally. The receiver samples the data on the positive transition of the clock.

■ SERIAL INPUT/OUTPUT LINES

● Receive Data (Rx Data)

The Receive Data line is a high impedance TTL compatible input through which data is received in a serial format. Data rates are from 0 to 600 kbps.

● Transmit Data (Tx Data)

The Transmit Data output line transfers serial data to a modem or other peripheral. Data rates are from 0 to 600 kbps.

■ PERIPHERAL/MODEM CONTROL

The SSDA includes several functions that permit limited control of a peripheral or modem. The functions included are CTS, SM/DTR, DCD, and TUF.

● Clear-to-Send (\bar{CTS})

The \bar{CTS} input provides a real-time inhibit to the transmitter

section (the Tx Data FIFO is not disturbed). A positive \overline{CTS} transition resets the Tx Shift Register and inhibits the TDRA status bit and its associated interrupt in both the one-sync-character and two-sync-character modes of operation. TDRA is not affected by the \overline{CTS} input in the external sync mode.

The positive transition of \overline{CTS} is stored within the SSDA to insure that its occurrence will be acknowledged by the system. The stored \overline{CTS} information and its associated \overline{IRQ} (if enabled) are cleared by writing a "1" in the Clear \overline{CTS} bit. The \overline{CTS} status bit subsequently follows the \overline{CTS} input when it goes "Low".

The \overline{CTS} input provides character timing for transmitter data when in the external sync mode. Transmission is initiated on the negative transition of the first full positive clock pulse of the transmitter clock (Tx CLK) after the release of \overline{CTS} (see Figure 6).

• **Data Carrier Detect (\overline{DCD})**

The \overline{DCD} input provides a real-time inhibit to the receiver section (the Rx FIFO is not disturbed). A positive \overline{DCD} transition resets and inhibits the receiver section except for the Receive FIFO and the RDRA status bit and its associated \overline{IRQ} .

The positive transition of \overline{DCD} is stored within the SSDA to insure that its occurrence will be acknowledged by the system. The stored \overline{DCD} information and its associated \overline{IRQ} (if enabled) are cleared by reading the Status Register and then the Receiver FIFO, or by writing a "1" into the Receiver Reset bit. The \overline{DCD} status bit subsequently follows the \overline{DCD} input when it goes "Low". The \overline{DCD} input provides character synchronization timing for the receiver during the external sync mode of operation. The receiver will be initialized and data will be sampled on the positive transition of the first full Receive Clock

cycle after release of \overline{DCD} (see Figure 7).

• **Sync Match/Data Terminal Ready (SM/\overline{DTR})**

The SM/\overline{DTR} output provides four functions (see Table 4) depending on the state of the PC1 and PC2 control bits. When the Sync Match mode is selected (PC1 = "1", PC2 = "0"), the output provides a one-bit-wide pulse when a sync code is detected. This pulse occurs for each sync code match even if the receiver has already attained synchronization. The SM output is inhibited when PC2 = "1". The \overline{DTR} mode (PC1 = "0") provides an output level corresponding to the complement of PC2 (\overline{DTR} = "0" when PC2 = "1".) (see Table 4.)

• **Transmitter Underflow (TUF)**

The Underflow output indicates the occurrence of a transfer of a "fill character" to the Transmitter Shift Register when the last location (#3) in the Transmit Data FIFO is empty. The Underflow output pulse is approximately a Tx CLK "High" period wide and occurs during the last half of the last bit of the character preceding the "Underflow" (see Figure 4). The Underflow output pulse does not occur when the Tx Sync bit is in the reset state.

■ **NOTE FOR USAGE**

If the hold time of \overline{CS} signal and R/\overline{W} signal is within 50~230 ns, there is a case that Transmit Data FIFO is not cleared and TDRA flag is not set when software reset using TxRS (TxRS=1) is executed. Usual program for data transmission will start to send the data as shown in Fig. 11 and Fig. 12.

In this case, the data of the first three bytes are not preset and unexpected data which is remaining in Transmit Data FIFO are sent in the first two bytes.

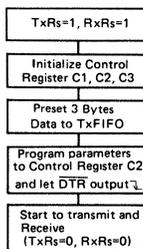


Figure 11 Normal Flow of Starting the Transmission and Reception

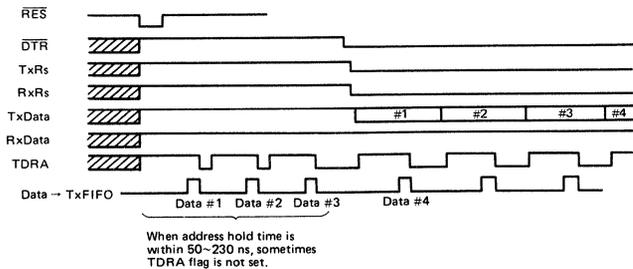
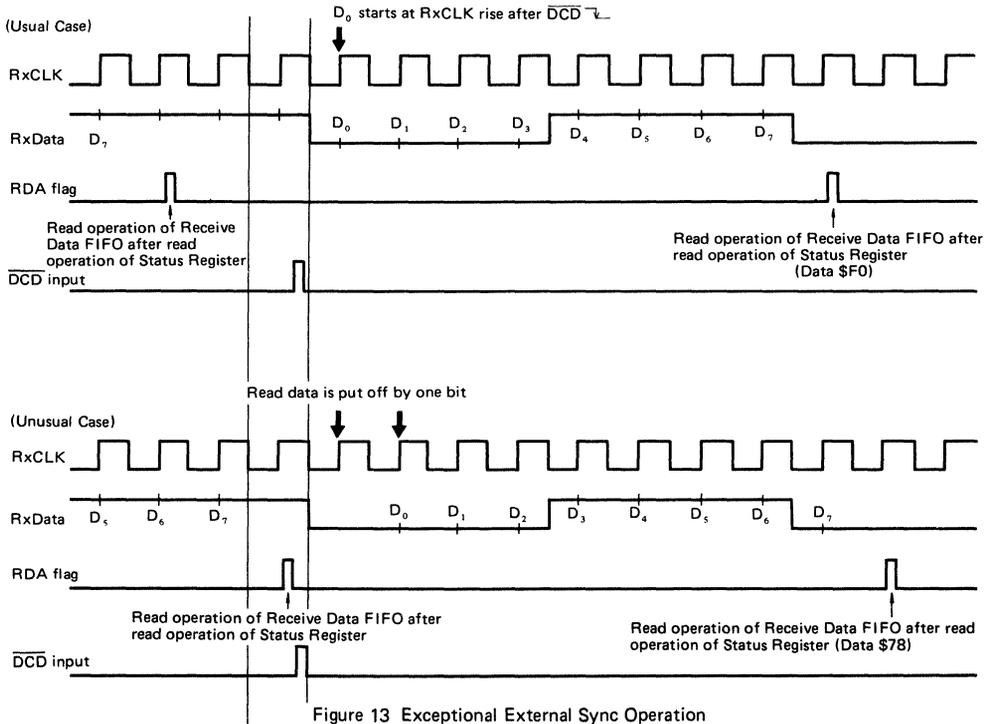


Figure 12 Transmission Start Sequence

In case of SSDA, Address Hold Time should be from 20 to 50 ns or over 230 ns.

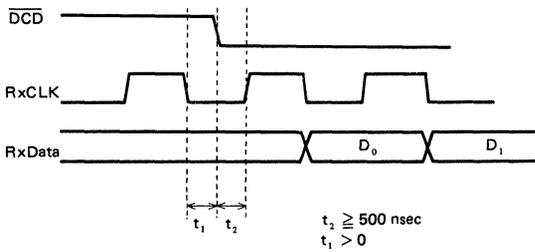
• **\overline{DCD} Input in External Synchronization Mode**

In case of receiving data in External Synchronization Mode, Receive data is put off by one bit at times, when \overline{DCD} is driven like \overline{f} in RxCLK cycle in which RDA flag is set.



To avoid this case, use SSDA in the following method.

- (1) \overline{DCD} \downarrow and RxCLK \downarrow should meet the relation shown in Fig. 14.



- (2) RxData should be input regarding the second RxCLK rise as D_0 bit, after \overline{DCD} \downarrow .

HD46508, HD46508-1, HD46508A, HD46508A-1 ADU (Analog Data Acquisition Unit)

The HD46508 is a monolithic NMOS device with a 10-bit analog-to-digital converter, a programmable voltage comparator, a 16-channel analog multiplexer and HMCS6800 microprocessor family compatible interface.

Each of 16 analog inputs is either converted to a digital data by the analog-to-digital converter or compared with the specified value by the programmable comparator. The analog-to-digital converter uses successive approximation method as the conversion technique. Its intrinsic resolution is 10 bits but it can be 8 bits if the programmer so desires. The programmable voltage comparator compares the input voltage with the value specified by the programmer. The result (greater than, or smaller than) is reflected to the flag in the status register.

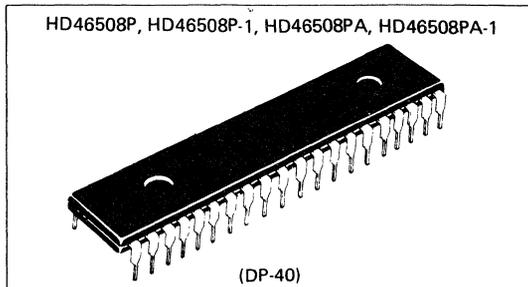
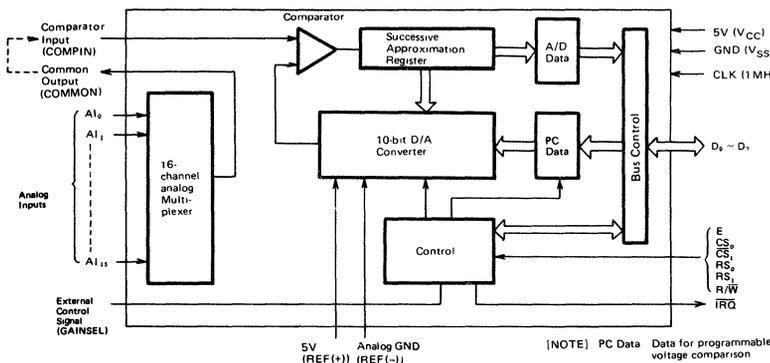
The device can expand its capability by controlling the external circuits such as sample holder, pre-amplifier and external multiplexer.

With these features, this device is ideally suited to applications such as process control, machine control and vehicle control.

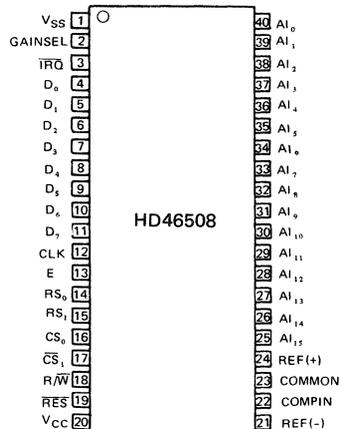
■ FEATURES

- 16-channel Analog multiplexer
- Programmable A/D Converter resolution (10-bit or 8-bit)
- Programmable Voltage comparison (PC)
- Conversion Time 100 μ s (A/D), 13 μ s (PC)
- External Sample and Hold Circuit Control
- Auto Range-switching Control of External Amplifier
- Waiting Function for the Settling Time of External Amplifier
- Interrupt Control (Only for A/D conversion)
- Single +5V Power Supply
- Compatible with HMCS6800 Bus (The connection with other Asynchronous Buses possible)

■ BLOCK DIAGRAM



■ PIN ARRANGEMENT

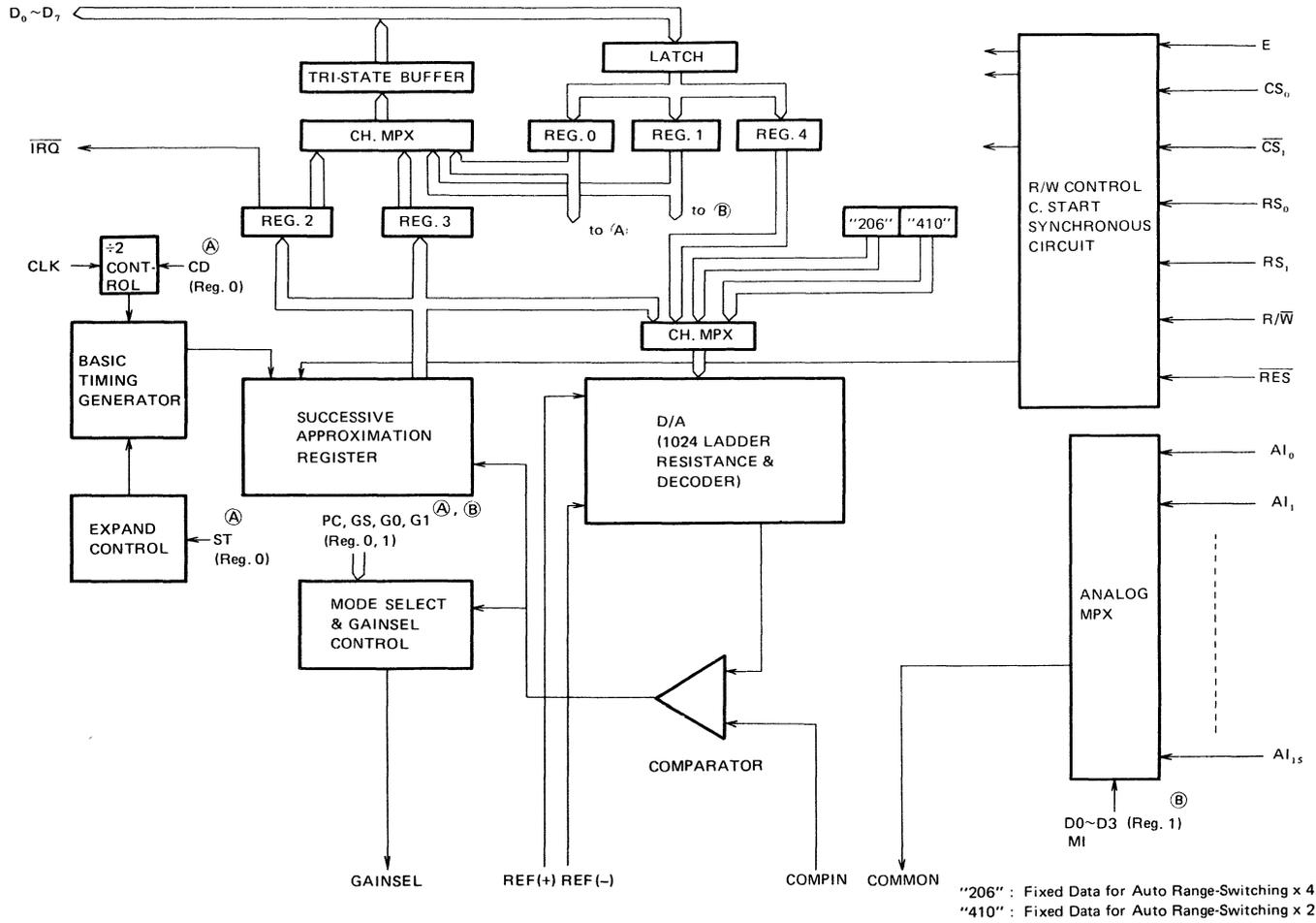


(Top View)

■ ORDERING INFORMATION

ADU	Bus Timing	Non Linearity*
HD46508A	1 MHz	
HD46508A-1	1.5 MHz	± 1 LSB
HD46508	1 MHz	
HD46508-1	1.5 MHz	± 3 LSB

* Specification for 10 bit A/D conversion



"206" : Fixed Data for Auto Range-Switching x 4
 "410" : Fixed Data for Auto Range-Switching x 2

Figure 1 Internal Block Diagram

■ ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Value	Unit
Supply Voltage	V_{CC}^*	-0.3 ~ +7.0	V
Input Voltage	V_{in}^*	-0.3 ~ +7.0	V
Analog Input Voltage	V_{Ain}^*	-0.3 ~ +7.0	V
Operating Temperature	T_{opr}	-20 ~ +75	°C
Storage Temperature	T_{stg}	-55 ~ +150	°C

* With respect to V_{SS} (SYSTEM GND)

[NOTE] Permanent LSI damage may occur if maximum ratings are exceeded. Normal operation should be under recommended operating conditions. If these conditions are exceeded, it could affect reliability of LSI.

■ RECOMMENDED OPERATING CONDITIONS

Item	Symbol	min	typ	max	Unit
Supply Voltage	V_{CC}^*	4.75	5.0	5.25	V
Input "High" Voltage	V_{IH}^*	2.0	—	V_{CC}	V
Input "Low" Voltage	V_{IL}^*	-0.3	—	0.8	V
Analog Input Voltage	V_{Ain}^*	0	—	$V_{REF(+)}$	V
Reference Voltage	$V_{REF(+)}^*$	—	V_{CC}	$V_{CC}+0.25$	V
	$V_{REF(-)}^*$	-0.1	0	—	
Voltage Center of Ladder	$\frac{V_{REF(+)} + V_{REF(-)}}{2}^*$	—	$\frac{V_{CC}}{2}$	$\frac{V_{CC}+0.25}{2}$	V
Operating Temperature	T_{opr}	-20	25	75	°C

*With respect to V_{SS} (SYSTEM GND)

■ ELECTRICAL CHARACTERISTICS
● DC CHARACTERISTICS <1> ($V_{CC} = 5V \pm 5\%$, $V_{SS} = 0V$, $T_a = -20 \sim +75^\circ C$, unless otherwise noted.)

Item	Symbol	Test Condition	min	typ	max	Unit	
Input "High" Voltage	V_{IH}		2.0	—	V_{CC}	V	
Input "Low" Voltage	V_{IL}		-0.3	—	0.8	V	
Output "High" Voltage	$D_0 \sim D_7$ GAINSEL	V_{OH}	$I_{OH} = -205\mu A$	2.4	—	—	V
			$I_{OH} = -200\mu A$	2.4	—	—	
			$I_{OH} = -10\mu A$	$V_{CC} - 1.0$	—	—	
Output "Low" Voltage	$D_0 \sim D_7, \overline{GAINSEL}$ \overline{IRQ}	V_{OL}	$I_{OL} = 1.6 \text{ mA}$	—	—	0.4	V
			$I_{OL} = 3.2 \text{ mA}$	—	—	0.4	
Input Leakage Current	I_{in}	$V_{in} = 0 \sim 5.25V$	-2.5	—	2.5	μA	
Three-State (off state) Input Current	I_{TSI}	$V_{in} = 0.4 \sim 2.4V$	-10	—	10	μA	
Output Leakage Current	I_{LOH}	$V_{OH} = 2.4V$	—	—	10	μA	
Power Dissipation	P_D		—	—	500	mW	
Input Capacitance	$D_0 \sim D_7$ E, CLK, R/W RES, RS ₀ , RS ₁ CS ₀ , CS ₁	C_{in}	$V_{in} = 0V, T_a = 25^\circ C$ $f = 1 \text{ MHz}$	—	—	12.5	pF
				—	—	10.0	
Output Capacitance	$\overline{IRQ}, \text{GAINSEL}$	C_{out}	$V_{in} = 0V, T_a = 25^\circ C$ $f = 1 \text{ MHz}$	—	—	10.0	pF

● DC CHARACTERISTICS <2> ($V_{CC} = 5V \pm 5\%$, $V_{SS} = 0V$, $T_a = -20 \sim +75^\circ C$, unless otherwise noted.)

Item	Test Condition	min	typ	max	Unit
Analog Multiplexer ON Resistance	$V_{Ain} = 5.0V$, $V_{CC} = 4.75V$, $T_a = 25^\circ C$	—	—	1	k Ω
OFF Channel Leakage Current	$V_{Ain} = 5.0V$ $V_{CC} = 4.75V$, $T_a = 25^\circ C$ COMMON = 0V	—	10	100	nA
	$V_{Ain} = 0V$, $T_a = 25^\circ C$ $V_{CC} = 4.75V$, COMMON = 5V	-100	-10	—	nA
Analog Multiplexer Input Capacitance		—	—	7.5	pF
Ladder Resistance (from REF(+) to REF(-))	$V_{REF(+)} = 5.0V$ $V_{REF(-)} = 0V$, $T_a = 25^\circ C$	10	—	40	k Ω

● CONVERTER SECTION ($T_a = 25^\circ C$, $V_{CC} = V_{REF(+)} = 5.0V$, $t_{CYC} = 1\mu s$, unless otherwise noted.)

1. 10-BIT A/D CONVERSION

Item	HD46508A, HD46508A-1			HD46508, HD46508-1			Unit
	min	typ	max	min	typ	max	
Resolution	—	10	—	—	10	—	bits
Non-linearity Error *	—	$\pm 1/2$	± 1	—	± 1	± 3	LSB
Zero-Error	—	$\pm 1/2$	$\pm 3/4$	—	$\pm 1/2$	± 1	LSB
Full-Scall Error	—	$\pm 1/4$	$\pm 1/2$	—	$\pm 1/2$	± 1	LSB
Quantization Error	—	—	$\pm 1/2$	—	—	$\pm 1/2$	LSB
Absolute Accuracy *	—	± 1	$\pm 3/2$	—	± 2	± 4	LSB

2. 8-BIT A/D CONVERSION

Item	HD46508A, HD46508A-1			HD46508, HD46508-1			Unit
	min	typ	max	min	typ	max	
Resolution	—	8	—	—	8	—	bits
Non-linearity Error *	—	$\pm 1/8$	$\pm 1/4$	—	$\pm 1/4$	$\pm 3/4$	LSB
Zero-Error	—	$\pm 1/4$	$\pm 3/8$	—	$\pm 3/8$	$\pm 1/2$	LSB
Full-Scall Error	—	$\pm 1/4$	$\pm 3/8$	—	$\pm 3/8$	$\pm 1/2$	LSB
Quantization Error	—	—	$\pm 1/2$	—	—	$\pm 1/2$	LSB
Absolute Accuracy *	—	$\pm 5/8$	$\pm 3/4$	—	$\pm 3/4$	$\pm 5/4$	LSB

3. PROGRAMMABLE VOLTAGE COMPARISON (PC)

Item	HD46508A, HD46508A-1			HD46508, HD46508-1			Unit
	min	typ	max	min	typ	max	
Resolution	—	8	—	—	8	—	bits
Non-linearity Error *	—	$\pm 1/8$	$\pm 1/4$	—	$\pm 1/4$	$\pm 3/4$	LSB
Zero-Error	—	$\pm 1/4$	$\pm 3/8$	—	$\pm 3/8$	$\pm 1/2$	LSB
Full-Scall Error	—	$\pm 1/4$	$\pm 3/8$	—	$\pm 3/8$	$\pm 1/2$	LSB
Absolute Accuracy *	—	$\pm 3/8$	$\pm 5/8$	—	$\pm 1/2$	± 1	LSB

*Temperature Coefficient; 25 ppm of FSR/ $^\circ C$ (max)

● AC CHARACTERISTICS ($V_{CC} = 5.0V \pm 5\%$, $V_{SS} = 0V$, $T_a = -20 \sim +75^\circ C$, unless otherwise noted.)

1. CLOCK WAVEFORM

Item	Symbol	Test Conditions	CD* = 0			CD* = 1			Unit
			min	typ	max	min	typ	max	
CLK Cycle Time	t_{cycC}	Fig. 2	1.0	—	10	0.5	—	5	μs
CLK "High" Pulse Width	PW_{CH}		0.45	—	4.5	0.22	—	2.2	μs
CLK "Low" Pulse Width	PW_{CL}		0.40	—	4.0	0.21	—	2.1	μs
Rise and Fall Time of CLK	t_{Cr} , t_{Cf}		—	—	25	—	—	25	ns

* CD : CLK Divider bit

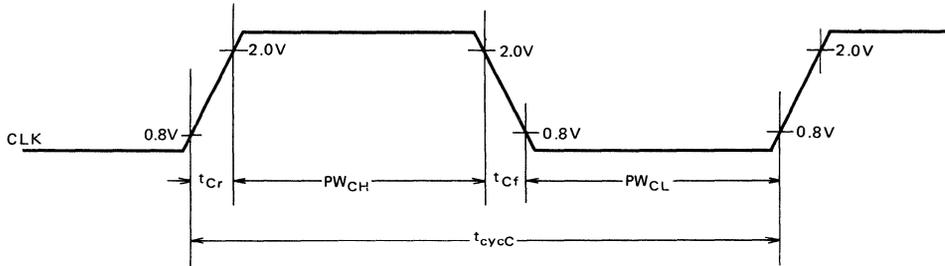


Figure 2 CLK Waveform

2. \overline{IRQ} , GAINSEL OUTPUT

Item	Symbol	Test condition	min	typ	max	Unit
\overline{IRQ} Release Time	t_{IR}	Fig. 3	—	—	750	ns
GAINSEL Delay Time	t_{GSD1}	Fig. 4	—	—	750	ns
	t_{GSD2}		—	—	750	ns

t_{GSD1} : TTL Load
 t_{GSD2} : CMOS Load

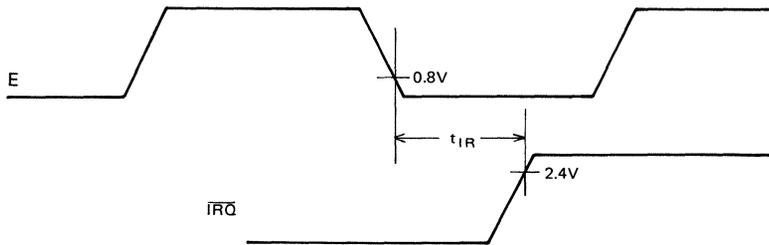
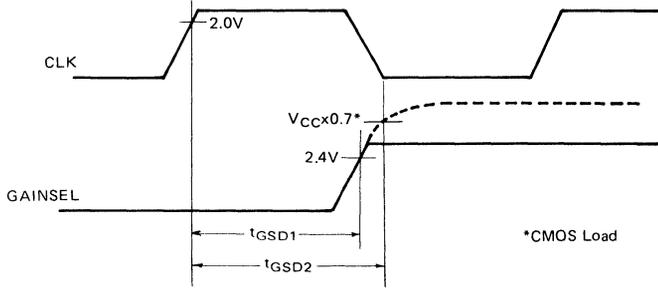


Figure 3 \overline{IRQ} Release Time

(1) Sample & Hold



(2) x2, x4 Auto Range-Switching, Programmable Gain

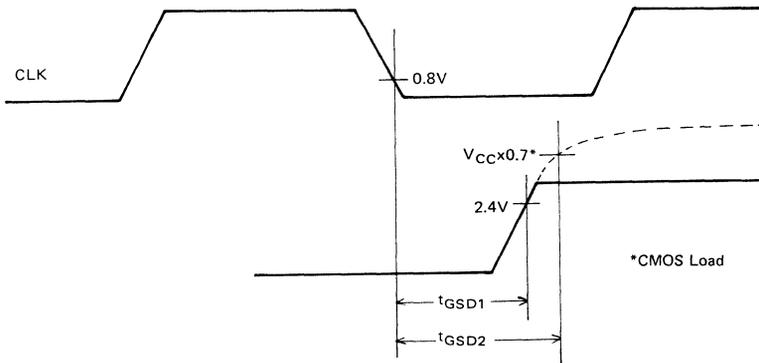


Figure 4 GAINSEL Delay Time

3. BUS TIMING CHARACTERISTICS
READ OPERATION SEQUENCE

Item	Symbol	Test Condition	HD46508 HD46508A			HD46508-1 HD46508A-1			Unit
			min	typ	max	min	typ	max	
Enable Cycle Time	t_{cycE}	Fig. 5	1.0	—	—	0.666	—	—	μs
Enable "High" Pulse Width	PW_{EH}		0.45	—	—	0.28	—	—	μs
Enable "Low" Pulse Width	PW_{EL}		0.40	—	—	0.28	—	—	μs
Rise and Fall Time of Enable	t_{Er}, t_{Ef}		—	—	25	—	—	25	ns
Address Set Up Time	t_{AS}		140	—	—	140	—	—	ns
Data Delay Time	t_{DDR}		—	—	320	—	—	220	ns
Data Access Time	t_{ACC}		—	—	460	—	—	360	ns
Data Hold Time	t_H		10	—	—	10	—	—	ns
Address Hold Time	t_{AH}		10	—	—	10	—	—	ns

WRITE OPERATION SEQUENCE

Item	Symbol	Test Condition	HD46508 HD46508A			HD46508-1 HD46508A-1			Unit
			min	typ	max	min	typ	max	
Enable Cycle Time	t_{cycE}	Fig. 6	1.0	—	—	0.666	—	—	μs
Enable "High" Pulse Width	PW_{EH}		0.45	—	—	0.280	—	—	μs
Enable "Low" Pulse Width	PW_{EL}		0.40	—	—	0.280	—	—	μs
Rise and Fall Time of Enable	t_{Er}, t_{Ef}		—	—	25	—	—	25	ns
Address Set Up Time	t_{AS}		140	—	—	140	—	—	ns
Data Set Up Time	t_{DSW}		195	—	—	80	—	—	ns
Data Hold Time	t_H		10	—	—	10	—	—	ns
Address Hold Time	t_{AH}		10	—	—	10	—	—	ns

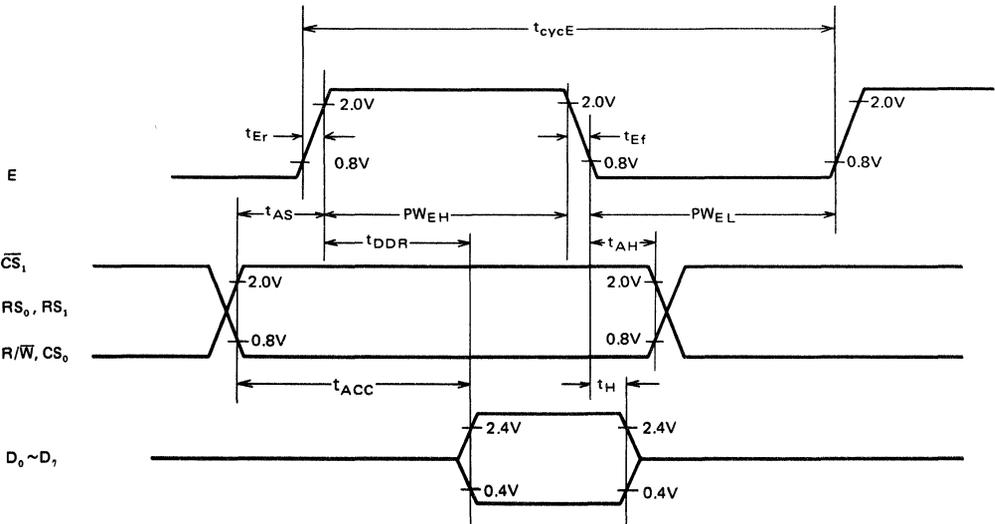


Figure 5 Read Timing

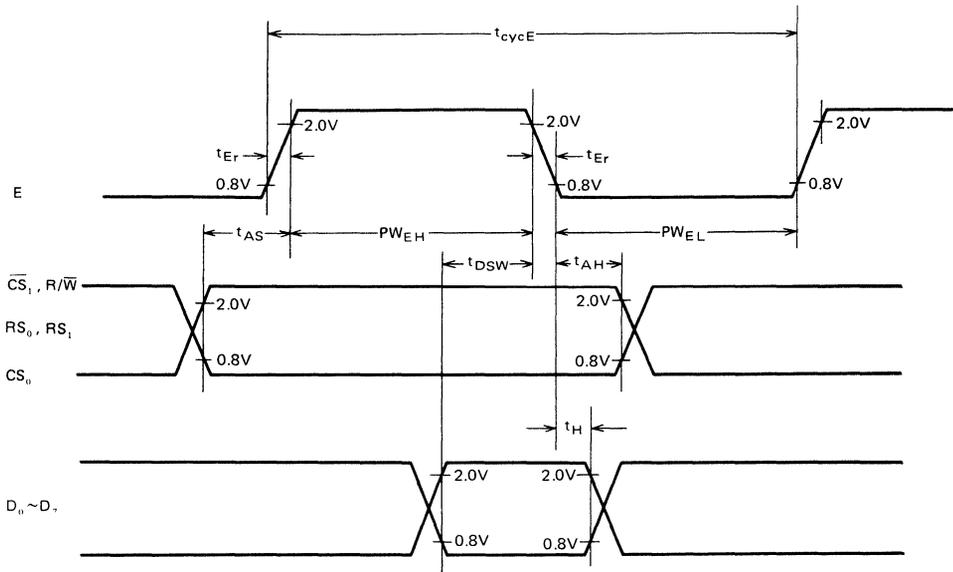


Figure 6 Write Timing

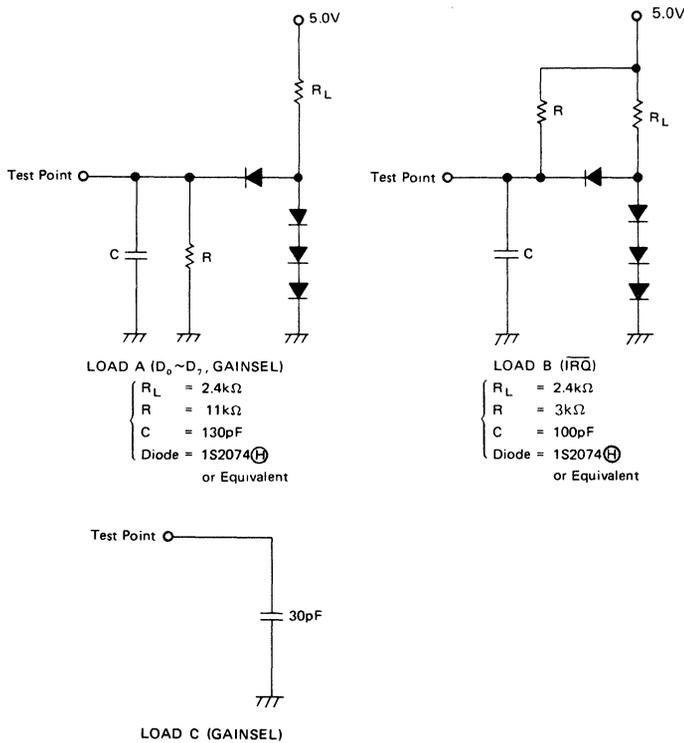


Figure 7 Test Load

■ SIGNAL DESCRIPTION

● Processor Interface

Data Bus (D₀~D₇)

The Bi-directional data lines (D₀~D₇) allow data transfer between the ADU and MPU. Data bus output drivers are three state buffers that remain in the high-impedance state except when MPU performs a ADU read operation.

Enable (E)

The Enable signal (E) is used as strobe signal in MPU R/W operation with the ADU internal registers. This signal is normally derived from the HMCS6800 system clock (φ₂).

Chip Select (CS₀, CS₁)

The Chip Select lines (CS₀, CS₁) are used to address the ADU. The ADU is selected when CS₀ is at "High" and CS₁ is at "Low" level.

Read/Write (R/W)

The R/W line controls the direction of data transfer between the ADU and MPU. When R/W is at "High" level, data of ADU is transferred to MPU. When R/W is at "Low" level, data of MPU is transferred to ADU.

Register Select (RS₀, RS₁)

The Register Select line (RS₀, RS₁) are used to select one of the 4 ADU internal registers. Table 1 shows the relation between (RS₀, RS₁) address and the selected register. The lowest 2 address lines of MPU are usually used for these signals.

Reset (RES)

This input is used to reset the ADU. An input "Low" level on RES line forces the ADU into following status.

- 1) All the shift-registers in ADU are cleared and the conversion operation is stopped.
- 2) The GAINSEL output goes down to "Low" level. The IRQ output is made "Off" state and the D₀~D₇ are made high impedance state.

Interrupt Request (IRQ) (Open Drain Output)

This output line is used to inform the A/D conversion end signal to the MPU. This signal becomes active "Low" level when IE bit in the control register 1 is "1" and IRQ bit in the control register 2 goes "1" at the end of conversion. And this signal returns to "High" right after The MPU reads the A/D Data Register (R3). Programmable voltage comparison

does not affect this signal.

● Analog Data Interface

Analog Input (AI₀~AI₁₅)

The Input Analog Data to be measured is applied to these Analog Input (AI₀~AI₁₅). These are multiplexed by internal 16 channel multiplexer and output to COMMOM pin. A particular input channel is selected when the multiplexer channel address is programmed into the control Register 1 (R1).

Multiplexer Common Output (COMMON)

This signal is the output of the 16 channel analog multiplexer, and may be connected to the input of pre-amplifier or sample/hold circuit according to user's purposes. When no external circuit needed, this output should be connected to the COMPIN input.

Comparator Input (COMPIN)

This is a high impedance input line that is used to transmit selected analog data to comparator. The COMMON line is usually connected to this input. When external Pre-amplifier or Sample/hold circuit is used, output of these circuits may be connected to this input.

Reference Voltage (+) (REF (+))

This line is used to apply the standard voltage to the internal ladder resistors.

Reference Voltage (-) (REF (-))

This line is connected to the analog ground.

● ADU Control

Conversion Clock (CLK)

The CLK is a standard clock input signals which defines internal timing for A/D conversion and PC operation.

Gain Select (GAINSEL) (CMOS Compatible Output)

This output is used to control the external circuit. The function of this signal is programmable and it is specified by (G1, G0) bits in Control Register 0. By using this output, user can control the auto-range-switching of external pre-amplifier, also control external sample & hold circuit, etc. as well.

[NOTE] This LSI is different from other HMCS6800 family LSIs in following function

- RES doesn't affect IE bit of R0

■ FUNCTION OF INTERNAL REGISTERS

● Structure

Table 1 Internal Registers of the ADU

CS ₁	CS ₀	RS ₁	RS ₀	Reg. #	Register Name	Read	Write	Data Bit									
								7	6	5	4	3	2	1	0		
0	1	0	0	R0	Control Register 0	○	○	IE	CD	ST	MI	D3	D2	D1	D0	G1	G0
0	1	0	1	R1	Control Register 1	○	○	SC	GS	PC	MI	D3	D2	D1	D0		
0	1	1	0	R2	Status & A/D Data Register (H)	○	x	IRQ	BSY	PCO	MI	OV	DW	C9	C8		
0	1	1	1	R3	A/D Data Register (L)	○	x	C7	C6	C5	C4	C3	C2	C1	C0		
0	1	1	1	R4	PC Data Register	x	○	B7	B6	B5	B4	B3	B2	B1	B0		

(Note) ○ --- YES
x --- NO

Control Register 0 (R0)

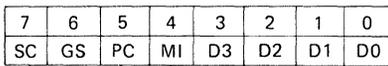


	"1"	"0"
Mode Select	See Table 2	
Not Used		
Not Used		
Not Used		
Settling Time	Available	Not Available
CLK Divider	CLK/2	CLK
Interrupt Enable*	Enable IRQ	Mask IRQ

Figure 8 Control Register 0

*RES doesn't affect IE bit.

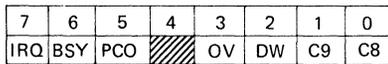
Control Register 1 (R1)



	"1"	"0"
MPX Channel Address	See Table 3	
MPX Inhibit	Inhibited	Not Inhibited
Prog. Comparator Select	Prog. Comparator mode	A/D Converter mode
GAINSEL Enable	GAINSEL Enable	GAINSEL Disable
Short-cycle Conversion	8-bit Length	10-bit Length

Figure 9 Control Register 1

Status & A/D Data Register (H)

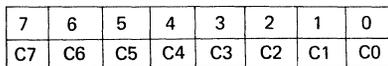


	"1"	"0"
Upper bit (10 bit data)		
Data Weight	See Table 4.	
Data Over Scale flag	Data is over scale	Within the scale
Not Used		
Programmable Comparator Output	$V_{Ain} > V_P$	$V_{Ain} < V_P$
Busy flag	Under Conversion	Conversion Completed
IRQ flag	Requested	Not Requested

V_{Ain} : Unknown Input Voltage
 V_P : Programmed Voltage by R4
 C9, C8 bits are cleared when 8 bit A/D conversion is performed.

Figure 10 Status & A/D Data Register (H)

A/D Data Register (L)



(Lower order 8 bit Data (Normal 10 bit Conversion)
 8 bit Data (8 bit Short-cycle Conversion)

Figure 11 A/D Data Register (L)

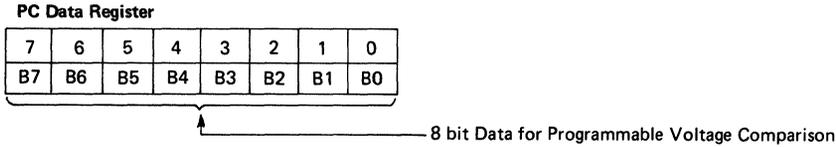


Figure 12 PC Data Register

● **Description for the Internal Registers**

Control Register 0 (R0)

This Register is a 5-bit read/write register that is used to specify Interrupt Enable (IE), CLK Divider (CD), Settling Time (ST) and Mode Select (G0, G1). This Register should be written before writing R1.

- IE bit: (Interrupt Enable)
 - IE = "1", Interrupt is requested through the \overline{IRQ} output.
 - IE = "0", Interrupt is masked.
- CD bit: (Clock Divider)
 - CD = "1", $CLK \div 2$ is used as internal clock.
 - CD = "0", CLK is used directly.
- ST bit: (Settling Time)
 - ST = "1", First comparison is executed after 1 expanded cycle in order to compensate external amplifiers settling delay.
 - ST = "0", Cycle is not delayed.
- G0, G1 bit; (Mode select)
 - These bits are used to specify the function of GAINSEL signal when GS bit is "1".

Table 2 Function of G0, G1

G1	G0	Mode Select
0	0	Sample & Hold
0	1	Auto Range-Switching x 2
1	0	Auto Range-Switching x 4
1	1	Programmable Gain Control

Control Register 1 (R1)

This register is an 8-bit read/write register that is used to store the command for A/D conversion mode and programmable comparison mode. This register includes MPX channel address ($D_0 \sim D_3$), MPX inhibit (MI), programmable comparator select (PC), GAINSEL enable (GS) and short-cycle conversion (SC) bits. When this register (R1) is programmed, each conversion mode starts.

- SC bit (Short-cycle)
 - SC = "1", Short-cycle conversion (8 bit length)
 - SC = "0", Normal conversion (10 bit length)
- GS bit (GAINSEL Enable)
 - GS = "1", GAINSEL signal is enabled. The function of GAINSEL is specified by (G0, G1) bits.
 - GS = "0", GAINSEL signal is disabled. ("Low" level)
- PC bit (Program comparator)
 - PC = "1", Programmable voltage comparator mode
 - PC = "0", A/D conversion mode
- MI bit (MPX Inhibit)
 - MI = "1", Internal MPX channel is inhibited in order to use external MPX channel.
 - MI = "0", Internal MPX channel is used.
- D0~D3 (MPX channel)
 - These bits are used to select the particular MPX channel.

Table 3 MPX Channel Addressing

Channel #1	D3	D2	D1	D0	Analog Input
0	0	0	0	0	AI ₀
1	0	0	0	1	AI ₁
2	0	0	1	0	AI ₂
3	0	0	1	1	AI ₃
4	0	1	0	0	AI ₄
5	0	1	0	1	AI ₅
6	0	1	1	0	AI ₆
7	0	1	1	1	AI ₇
8	1	0	0	0	AI ₈
9	1	0	0	1	AI ₉
10	1	0	1	0	AI ₁₀
11	1	0	1	1	AI ₁₁
12	1	1	0	0	AI ₁₂
13	1	1	0	1	AI ₁₃
14	1	1	1	0	AI ₁₄
15	1	1	1	1	AI ₁₅

Table 4 Function Select

PC	SC	Function	GS	(G0, G1)
0	0	10 bit AD CONV.	0	DISABLE
			1	ENABLE*
	1	8 bit AD CONV.	0	DISABLE
			1	ENABLE*
1	x	PROG. COMP (8 bit)	x	DISABLE

x = Do not care

* = See Table 6

[NOTE] CD bit and ST bit are effective in every case.

Status & A/D Data Register (H) (R2)

This register is a 7-bit read only register that is used to store the upper 2-bit data (C8, C9), data weight (DW), data overscale (OV), programmable comparator output (PCO), busy (BSY) and interrupt request (IRQ).

(C8, C9) : These bits store upper 2-bit data measured by 10 bit length conversion.
(Upper bit data)

DW bit : This bit indicates data weight when Auto range-switching mode is selected. This bit is set or reset when the conversion has completed. The conditions are shown in following Table. In this mode GAINSEL output also goes "High" or "Low" on the same condition shown in Table 5. Other status of DW bit is shown in Table 6.

OV bit (Over scale) : This bit is set when analog data is greater than or equal to reference Voltage ($V_{REF(+)}$).

PCO bit (Programmable comparator Output) : This bit indicates the result of programmable voltage comparison.
 "1" → PCO $V_{Ain} > V_p$
 "0" → PCO $V_{Ain} < V_p$
 V_{Ain} : Analog Input Voltage to be compared
 V_p : Programmed Voltage (R4)

BSY bit (Busy) : This bit indicates that the ADU is now under conversion.

IRQ bit (Interrupt Request) : This bit is set when the A/D conversion has completed and cleared by reading the R3.

A/D Data Register (L) (R3)

This register is an 8-bit read-only register that is used to store the lower 8 bits data of 10-bit conversion or full 8 bits data of the 8-bit conversion.

PC Data Register (R4)

This register is an 8-bit write-only register prepared for Programmable Voltage comparison. Stored data is converted to digital voltage, and compared with analog input to be measured. The result of comparison is set into PCO bit.

Table 5 Data Weight (DW) Set or Reset Condition

Mode	Condition	Set ("1")	Reset ("0")
		Auto Range-Switching (x2)	$V_{Ain} < \frac{410}{1024} \cdot V_{REF(+)}$
Auto Range-Switching (x4)	$V_{Ain} < \frac{206}{1024} \cdot V_{REF(+)}$	$V_{Ain} > \frac{206}{1024} \cdot V_{REF(+)}$	

V_{Ain} : Analog Input Voltage to be measured

$V_{REF(+)}$: Voltage Applied to REF(+)

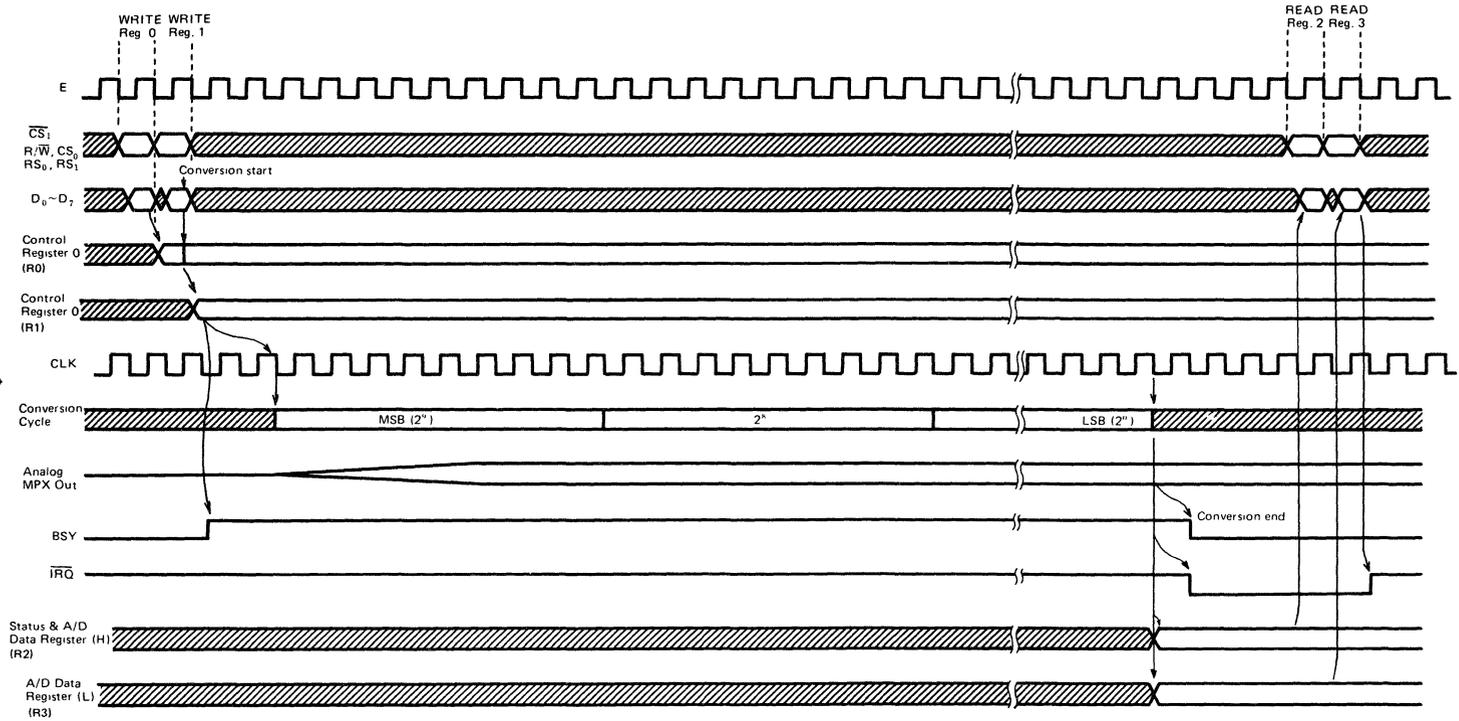


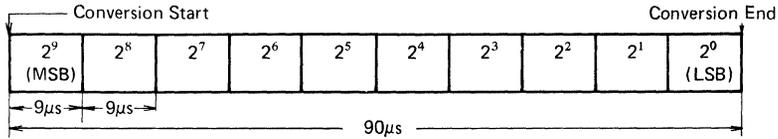
Figure 13 A/D Conversion Timing Chart (Basic Sequence)

● A/D Conversion and PC sequence ($t_{cyc}=1\mu s$)

10 bits A/D Conversion

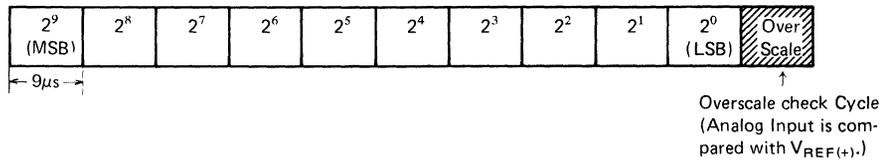
1) Basic Sequence

(SC = "0"
ST = "0"
GS = "0")



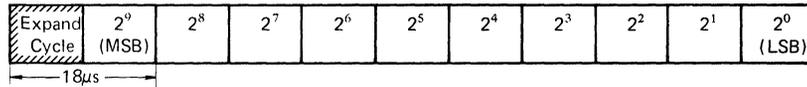
2) Basic Sequence

(When overscale is detected)



3) Expanded Sequence

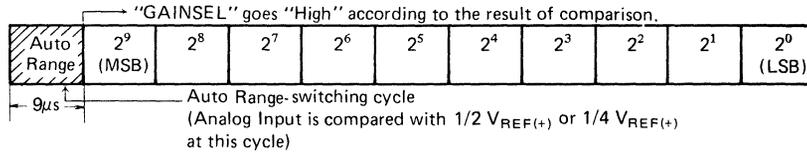
(SC = "0"
ST = "1"
GS = "0")



MSB cycle is expanded to compensate external amplifier's settling delay.

4) Auto Range-Switching Control Sequence

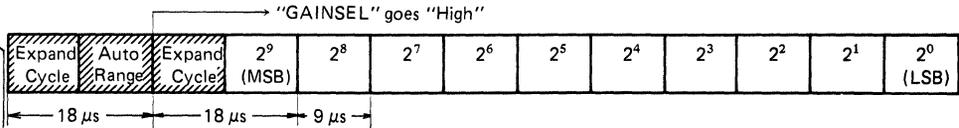
(SC = "0"
ST = "0"
GS = "1"
G0 = "0"
G1 = "1")
or
(SC = "0"
ST = "0"
GS = "1"
G0 = "1"
G1 = "0")



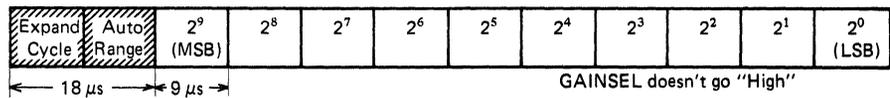
5) Auto Range-Switching & Expansion Control Sequence

(SC = "0"
ST = "1"
GS = "1"
G0 = "0"
G1 = "1")
or
(SC = "0"
ST = "1"
GS = "1"
G0 = "1"
G1 = "0")

a) Analog Input <math>< 1/2 V_{REF(+)}</math> or $1/4 V_{REF(+)}$

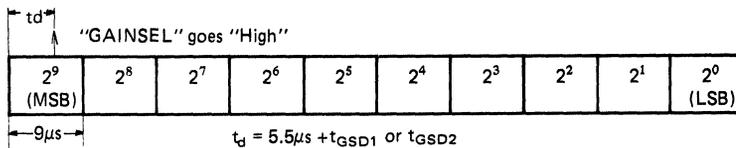


b) Analog Input >math>1/2 V_{REF(+)}</math> or >math>1/4 V_{REF(+)}</math>



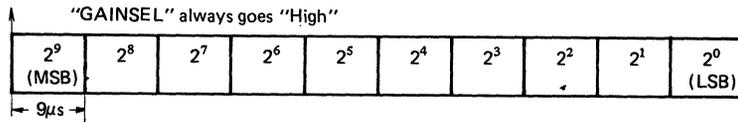
6) Sample & Hold Control Sequence

(SC = "0"
ST = "0"
GS = "1"
G0 = "0"
G1 = "0")



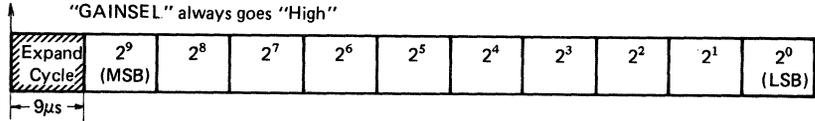
7) Programmable Gain Control Sequence

SC = "0"
ST = "0"
GS = "1"
G0 = "1"
G1 = "1"



8) Programmable Gain & Expansion Control Sequence

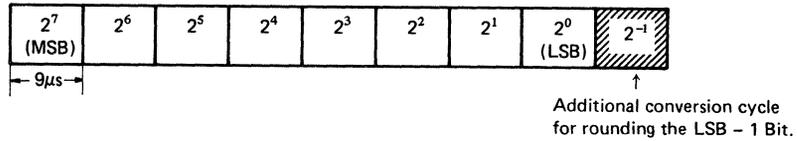
SC = "0"
ST = "1"
GS = "1"
G0 = "1"
G1 = "1"



8 Bit A/D Conversion

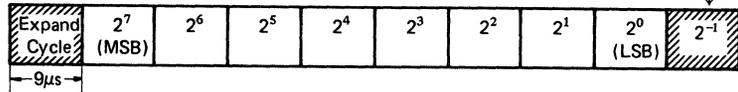
1) Basic Sequence

SC = "1"
ST = "0"
GS = "0"



2) Expanded Sequence

SC = "1"
ST = "1"
GS = "0"



Programmable Voltage Comparison

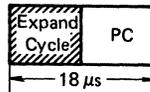
1) Basic Sequence

PC = "1"
ST = "0"



2) Expanded Sequence

PC = "1"
ST = "1"



■ HOW TO USE THE ADU

● Functions of GAINSEL

The ADU is equipped with programmable GAINSEL output signal. By using GAINSEL output and external circuit, the ADU is able to implement following control.

- 1) Auto Range-Switching (Auto Gain) Control
 - 2) Programmable Gain control
 - 3) Sample & Hold control
- GAINSEL output is controlled by Mode Select bit (G0, G1) when GAINSEL enable bit (GS) is "1".

Table 6 GAINSEL Control

GS	G1	G0	GAINSEL	Control Mode	DW
0	x	x	"Low"	Normal Use (GAINSEL is not used)	0
1	0	0	"High"	Sample & Hold control	0
1	0	1	*	Auto Range Switching x 2 control	**
1	1	0	*	Auto Range Switching x 4 control	**
1	1	1	"High"	Programmable Gain control	1

* GAINSEL goes "High" or "Low" according to the condition shown in Table 5.

** See, Table 5.

How to Control External Circuit

(1) Sample & Hold Control (G1=0, G0=0)

An example of Sample & Hold circuit is shown in Fig. 14. When ADU is set in Sample & Hold Control Mode, GAINSEL becomes "High" level on conversion and controls the data holding.

(2) Automatic Range Switching Control (G1=0, G0=1 or G1=1, G0=0)

The GAINSEL signal controls the external amplifier which can change the ratio of voltage amplification. (GAIN: 1 → 2 times or 1 → 4 times). Fig. 15 shows Automatic Range Switching Control. In this case, when the input voltage is lower than 206/1024 $V_{REF(+)}$, GAINSEL becomes "High" level. This makes the GAIN of the amplifier change from 1 to 4 times, and 4 times value of the input voltage is A/D converted. Using this function even if an input signal is small, it is possible to execute A/D conversion in nearly full scale. In this mode, when GAINSEL signal becomes "High", DW bit becomes "1" to show the range switching is in a progress.

(3) Programmable GAIN Control (G1=1, G0=1)

The GAINSEL signal is used for controlling the external amplifier of any GAIN which is fit to the system.

In this mode, GAINSEL always becomes "High" at the beginning of A/D conversion, so the change of range is controlled by GS bit. Converted data need to be corrected in software in accordance with GAIN of the amplifier.

This mode is effective in the case of converting very small input voltage.

(Note) Refer to "ADU Function Sequence" (A/D Conversion and PC Sequence) for the timing in which GAINSEL signal becomes "High". GAINSEL signal becomes "Low" in accordance with "1" → "0" change of BSY bit. Refer to Fig. 13.

x1 Sample & Hold

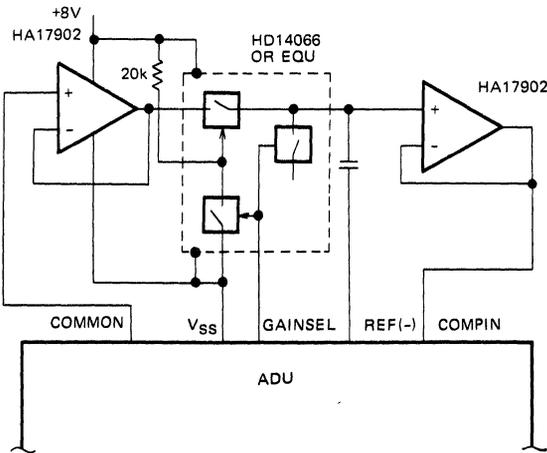


Figure 14 Sample & Hold Circuit

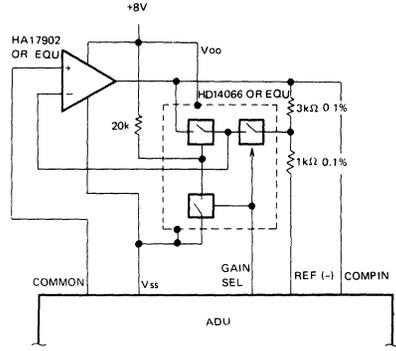
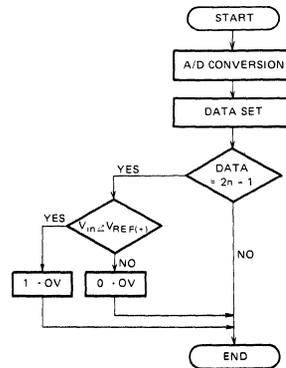


Figure 15 Pre-amplifier Circuit
(x1, x4 Auto-Range Switching)

• **Overscale Check**

ADU is equipped with hardware overscale detection function. The overscale detection is performed automatically when the result of A/D conversion is $2^n - 1$ (all bits = 1). When analog input V_{in} is higher than $V_{REF(+)}$, overscale bit (OV) is set to "1". The definition of the overscale is illustrated in Fig. 17. And the flow of overscale check is shown in Fig. 16.



OV	DATA	NOTE
0	11.....1	NOT OVERSCALE
1	11.....1	OVERSCALE

Figure 16 Overscale Check Flow

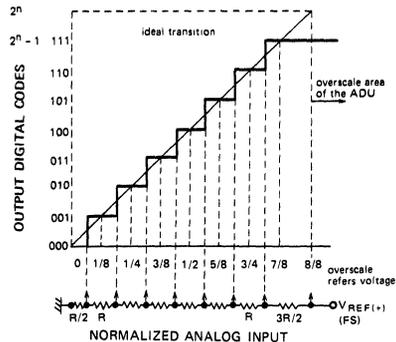


Figure 17 Definition ADU's Overscale

• Usage of the PC

The ADU has a programmable threshold voltage comparator (PC) function. The threshold voltage is pre-settable from 0V to 5V range with 8 bit resolution. The comparator's

output is stored into PCO bit at the end of comparision.

The programmable voltage comparison time is so short that the interrupt is not requested at this mode. The end of comparison needs to be confirmed by reading the 1→0 transition of the BSY bit in R2.

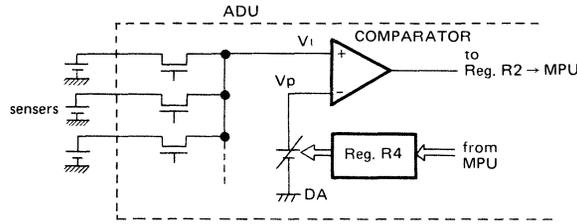


Figure 18 Function Diagram of the PC

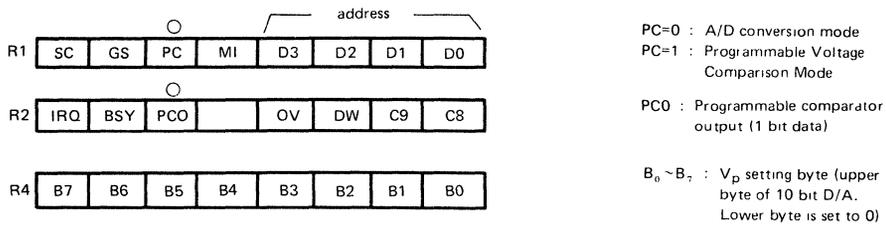


Figure 19 Registers of the PC Mode

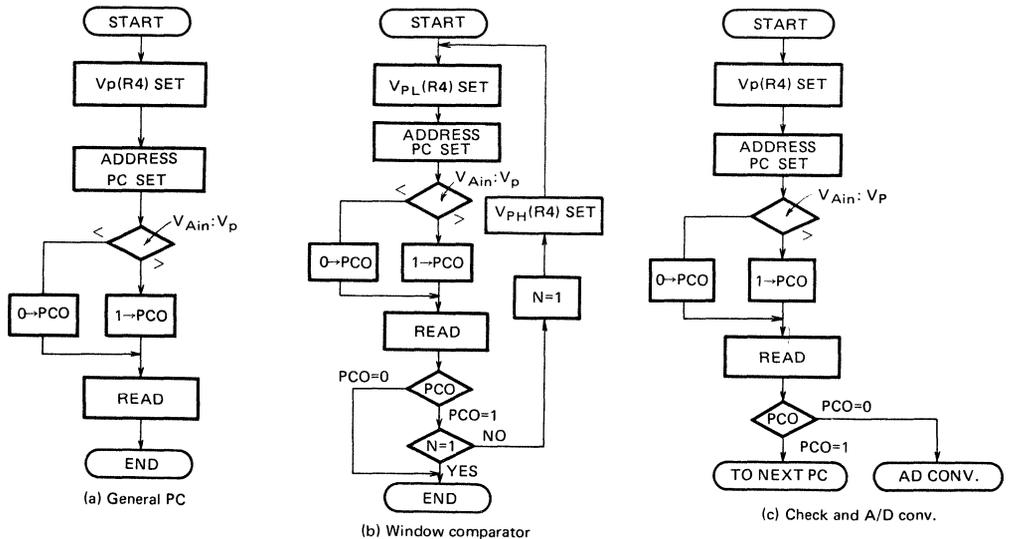


Figure 20 PC Application Flow Chart Examples

■ DEFINITIONS OF ACCURACY

Definitions of accuracy applied to HD46508 are as follows.

- (1) Resolution . . . The number of output binary digit.
- (2) Offset Error . . . The difference between actual input voltage and ideal input voltage for the first transition. (when digital output code is changed from 000 . . . 00 to 000 . . . 01.)
- (3) Full Scale Error . . . The difference between actual input voltage and ideal input voltage for the final transition. (when digital output code is changed from 111 . . . 10 to

111 . . . 11.)

- (4) Quantizing Error . . . Error equipped in A/D converter inherently. Always $\pm\frac{1}{2}$ LSB is applied.
- (5) Non-linearity Error . . . The maximum deviation of the actual transfer line from an ideal straight line. This error doesn't include Quantizing Error, Offset, or Full Scale Errors.
- (6) Absolute Accuracy . . . The deviation of the digital output code from an analog input voltage. Absolute accuracy includes all of (2), (3), (4), (5).

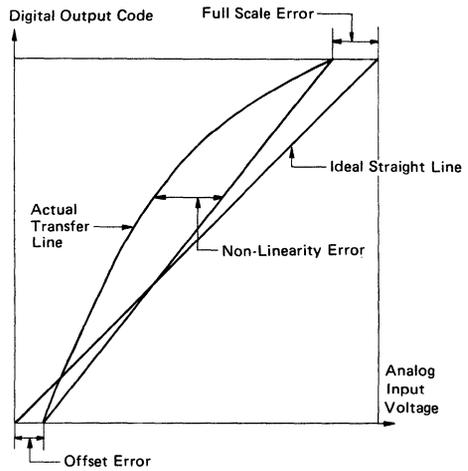
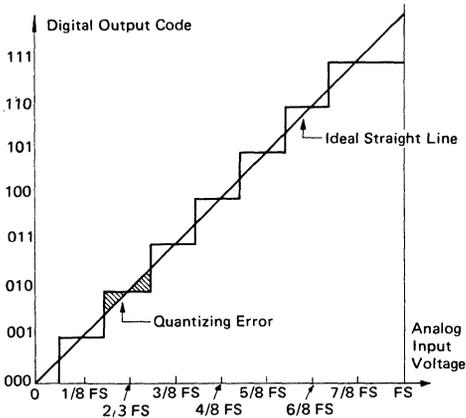


Figure 24 Definition of Accuracy

HD146818

RTC (Real Time Clock Plus RAM)

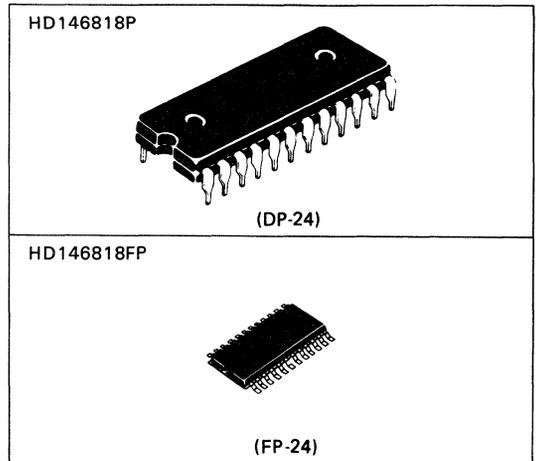
The HD146818 is a HMCS6800 peripheral CMOS device which combines three unique features: a complete time-of-day clock with alarm and one hundred calendar, a programmable periodic interrupt and square-wave generator, and 50 bytes of Low-power static RAM.

This device includes HD6801, HD6301 multiplexed bus interface circuit and 8085's multiplexed bus interface as well, so it can be directly connected to HD6801, HD6301 and 8085.

The Real-Time Clock plus RAM has two distinct uses. First, it is designed as battery powered CMOS part including all the common battery backed-up functions such as RAM, time, and calendar. Secondly, the HD146818 may be used with a CMOS microprocessor to relieve the software of timekeeping workload and to extend the available RAM of an MPU such as the HD6301.

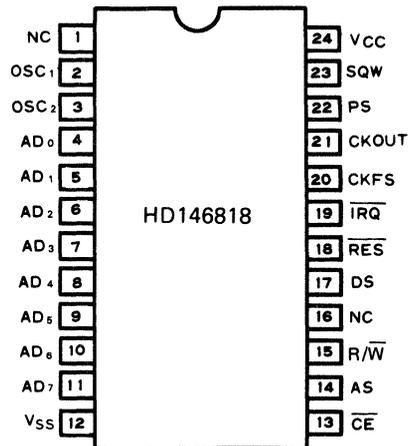
■ FEATURES

- Time-of-Day Clock and Calendar
 - Counts Seconds, Minutes, and Hours of the Day
 - Counts Days of Week, Date, Month, and Year
- Binary or BCD Representation of Time, Calendar, and Alarm
- 12- or 24 Hour Clock with AM and PM in 12-Hour Mode
- Automatic End of Month Recognition
- Automatic Leap Year Compensation
- Interfaced with Software as 64 RAM Locations
 - 14 Bytes of Clock and Control Register
 - 50 Bytes of General Purpose RAM
- Three Interrupt are Separately Software Maskable and Testable
 - Time-of-Day Alarm, Once-per-Second to Once-per-Day
 - Periodic Rates from 30.5 μ s to 500ms
 - End-of-Clock Update Cycle
- Programmable Square-Wave Output Signal
- Three Time Base Input Options
 - 4.194304 MHz
 - 1.048576 MHz
 - 32.768 kHz
- Clock Output May be used as Microprocessor Clock Input
 - At Time Base Frequency $\div 4$ or $\div 1$
- Multiplexed Bus Interface Circuit of HD6801, HD6301 and 8085
- Low-Power, High-Speed, High-Density CMOS
- Battery Backed-up Operation
- Motorola MC146818 Compatible



The Flat Package product is under development.

■ PIN ARRANGEMENT



(Top View)

■ ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Value	Unit
Supply Voltage	V_{CC} *	-0.3 ~ +7.0	V
Input Voltage	V_{in} *	-0.3 ~ +7.0	V
Operating Temperature	T_{opr}	0 ~ +70	$^{\circ}$ C
Storage Temperature	T_{stg}	-55 ~ +150	$^{\circ}$ C

* With respect to V_{SS} (SYSTEM GND)

(NOTE) Permanent LSI damage may occur if maximum rating are exceeded. Normal operation should be under recommended operating condition. If these conditions are exceeded, it could affect reliability of LSI.

■ RECOMMENDED OPERATING CONDITIONS

Item	Symbol	min	typ	max	Unit
Supply Voltage	V_{CC}^*	4.5	5.0	5.25	V
Input Voltage	V_{IL}^*	-0.3	-	0.7	V
	V_{IH}^*	$V_{CC}-1.0$	-	V_{CC}	V
Operating Temperature	T_{opr}	0	25	70	°C

* With respect to V_{SS} (SYSTEM GND)

(NOTE) Refer to Battery Backed-up Electrical characteristics.

■ ELECTRICAL CHARACTERISTICS

● DC CHARACTERISTICS ($V_{CC} = 4.5 \sim 5.25V$, $V_{SS} = 0V$, $T_a = 0 \sim +70^\circ C$, unless otherwise noted.)

Item	Symbol	Test Condition	min	typ	max	Unit		
Input "High" Voltage	V_{IH}	$AD_0 \sim AD_7, \overline{CE}, AS, R/\overline{W}, DS, CKFS, PS$		$V_{CC}-2.0$	-	V_{CC}	V	
		\overline{RES}		$V_{CC}-1.0$	-	V_{CC}		
		OSC_1		$V_{CC}-1.0$	-	V_{CC}		
Input "Low" Voltage	V_{IL}	$AD_0 \sim AD_7, \overline{CE}, AS, R/\overline{W}, DS, CKFS, PS$		-0.3	-	0.7	V	
		\overline{RES}		-0.3	-	0.8		
		OSC_1		-0.3	-	0.8		
Input Leakage Current	$ I_{in} $	$OSC_1, \overline{CE}, AS, R/\overline{W}, DS, \overline{RES}, CKFS, PS$	-	-	2.5	μA		
Three-state (off state) Input Current	$ I_{TSI} $	$AD_0 \sim AD_7$	-	-	10	μA		
Output Leakage Current	I_{LOH}	\overline{IRQ}	-	-	10	μA		
Output "High" Voltage	V_{OH}	$AD_0 \sim AD_7$	$I_{OH} = -1.6 \text{ mA}$	4.1	-	-	V	
		$SQW, CKOUT$						
		$AD_0 \sim AD_7$	$I_{OH} < -10 \mu A$	$V_{CC}-0.1$	-	-		
Output "Low" Voltage	V_{OL}	$AD_0 \sim AD_7$	$I_{OL} = 1.6 \text{ mA}$	-	-	0.5	V	
		$CKOUT$	$I_{OL} = 1.6 \text{ mA}$					
		\overline{IRQ}, SQW	$I_{OL} = 1.6 \text{ mA}$					
Input Capacitance	C_{in}	$AD_0 \sim AD_7$	$V_{in} = 0V$ $T_a = 25^\circ C$ $f = 1 \text{ MHz}$	-	-	12.5	pF	
		All inputs except $AD_0 \sim AD_7$		-	-	12.5	pF	
Output Capacitance	C_{out}	$SQW, CKOUT, \overline{IRQ}$	-	-	12.5	pF		
Supply Current (MPU Read/Write operating)	Crystal Oscillation	I_{CC}^*	$V_{CC} = 5.0V$ SQW : disable $CKOUT = f_{OSC}$ (No Load) $t_{cyc} = 1 \mu s$ Circuit: Fig. 11 Parameter: Table 1	$f_{OSC} = 4 \text{ MHz}$	-	-	10	mA
				$f_{OSC} = 1 \text{ MHz}$	-	-	7	
				$f_{OSC} = 32 \text{ kHz}$	-	-	5	
Supply Current** (MPU not operating)	Crystal Oscillation	I_{CC}^*	$V_{CC} = 5.0V$ SQW : disable $CKOUT = f_{OSC}$ (No Load) $t_{cyc} = 1 \mu s$ Circuit: Fig. 11 Parameter: Table 1	$f_{OSC} = 4 \text{ MHz}$	-	-	5	mA
				$f_{OSC} = 1 \text{ MHz}$	-	-	2	
				$f_{OSC} = 32 \text{ kHz}$	-	300	500	
Supply Current (MPU Read/Write operating)	External Clock	I_{CC}^*	$V_{CC} = 5.0V$ SQW : disable $CKOUT = f_{OSC}$ (No Load) OSC_2 : open $t_{cyc} = 1 \mu s$ Circuit: Fig. 17	$f_{OSC} = 4 \text{ MHz}$	-	-	10	mA
				$f_{OSC} = 1 \text{ MHz}$	-	-	7	
				$f_{OSC} = 32 \text{ kHz}$	-	-	5	
Supply Current** (MPU not operating)	External Clock	I_{CC}^*	$V_{CC} = 5.0V$ SQW : disable $CKOUT = f_{OSC}$ (No Load) OSC_2 : open $t_{cyc} = 1 \mu s$ Circuit: Fig. 17	$f_{OSC} = 4 \text{ MHz}$	-	-	4	mA
				$f_{OSC} = 1 \text{ MHz}$	-	-	1	
				$f_{OSC} = 32 \text{ kHz}$	-	60	100	

* Supply current of HD146818 is defined as the value when the time-base frequency to be used is programmed into Register A. When power is turned on, these bits are unfixed, so there is a case that current more than the above specification may flow. Please never fail to set the time-base frequency after turning on power supply.

** $V_{IH \text{ min}} = V_{CC}-0.2V$
 $V_{IL \text{ max}} = V_{SS}+0.2V$

● AC CHARACTERISTICS ($V_{CC} = 4.5 \sim 5.25V$, $V_{SS} = 0V$, $T_a = 0 \sim +70^\circ C$, unless otherwise noted.)

BUS TIMING

Item	Symbol	min	typ	max	Unit
Cycle Time	t_{cyc}	953	—	—	ns
Pulse Width, AS/ALE "High"	PW_{ASH}	100	—	—	ns
AS Rise Time	t_{ASr}	—	—	30	ns
AS Fall Time	t_{ASf}	—	—	30	ns
Delay Time DS/E to AS/ALE Rise	t_{ASD}	40	—	—	ns
DS Rise Time	t_{DSr}	—	—	30	ns
DS Fall Time	t_{DSf}	—	—	30	ns
Pulse Width, DS/E Low or $\overline{RD}/\overline{WR}$ "High"	PW_{DSH}	325	—	—	ns
Pulse Width, DS/E High or $\overline{RD}/\overline{WR}$ "Low"	PW_{DSL}	300	—	—	ns
Delay Time, AS/ALE to DS/E Rise	t_{ASDS}	90	—	—	ns
Address Setup Time (R/\overline{W})	t_{AS1}	15	—	—	ns
Address Setup Time (\overline{CE})	t_{AS2}	55	—	—	ns
Address Hold Time (R/\overline{W} , \overline{CE})	t_{AH}	10	—	—	ns
Muxed Address Valid Time to AS/ALE Fall	t_{ASL}	50	—	—	ns
Muxed Address Hold Time	t_{AHL}	20	—	—	ns
Peripheral Data Setup Time	t_{DSW}	195	—	—	ns
Write Data Hold Time	t_{DHW}	0	—	—	ns
Peripheral Output Data Delay Time From DS/E or \overline{RD}	t_{DDR}	—	—	220	ns
Read Data Hold Time	t_{DHR}	10	—	—	ns

CONTROL SIGNAL TIMING

Item	Symbol	min	typ	max	Unit	
Oscillator Startup	t_{RC}	1 MHz, 4 MHz	—	—	100	ms
		32 kHz	—	—	1000	
Reset Pulse Width	t_{RWL}	5.0	—	—	μs	
Reset Delay Time	t_{RLH}	5.0	—	—	μs	
Power Sense Pulse Width	t_{PWL}	5.0	—	—	μs	
Power Sense Delay Time	t_{PLH}	5.0	—	—	μs	
\overline{IRQ} Release from DS	t_{IRDS}	—	—	2.0	μs	
\overline{IRQ} Release from RES	t_{IRR}	—	—	2.0	μs	
VRT Bit Delay	t_{VRTD}	—	—	2.0	μs	

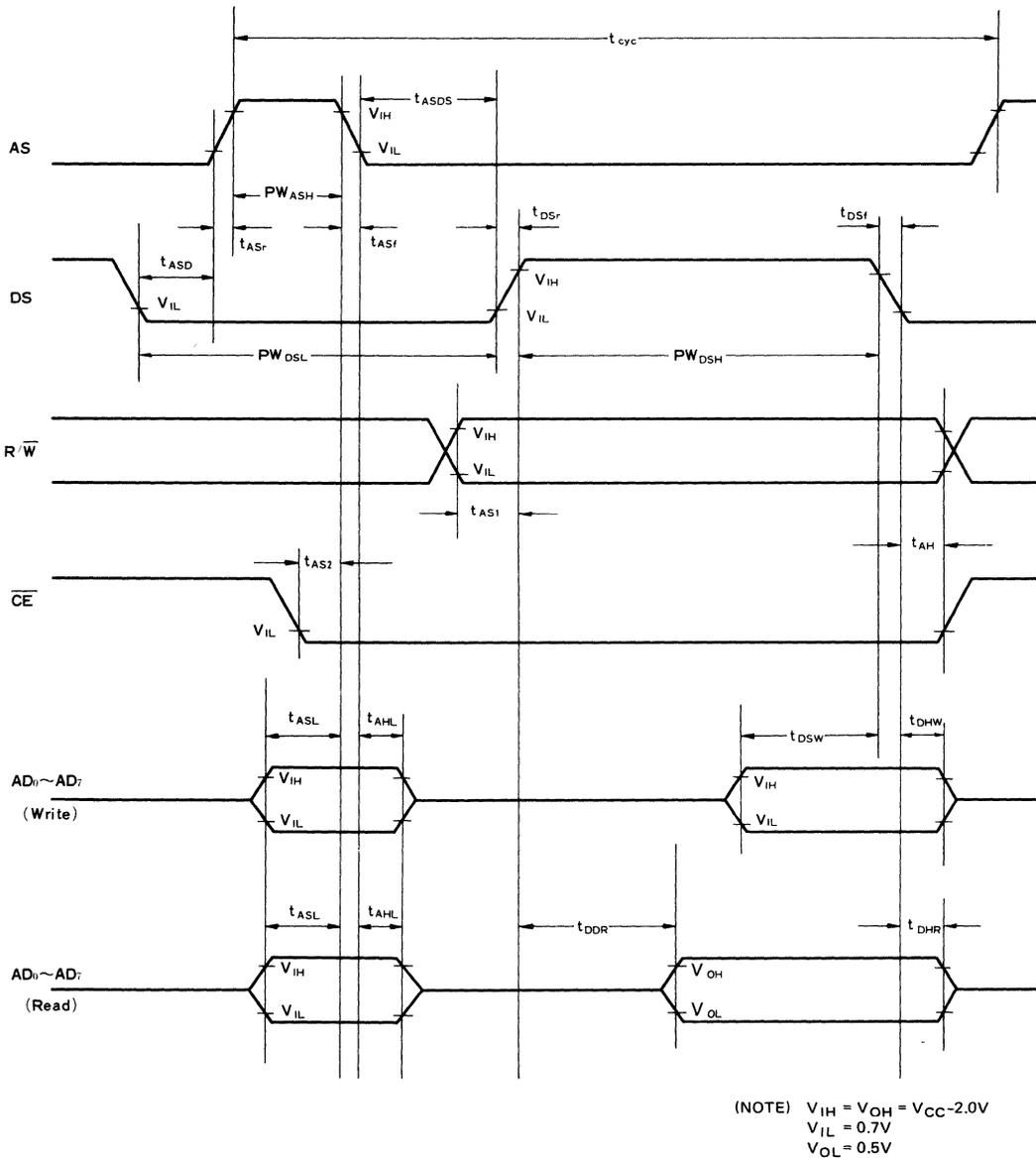


Figure 1 Bus Read, Write Timing (6801 Family)

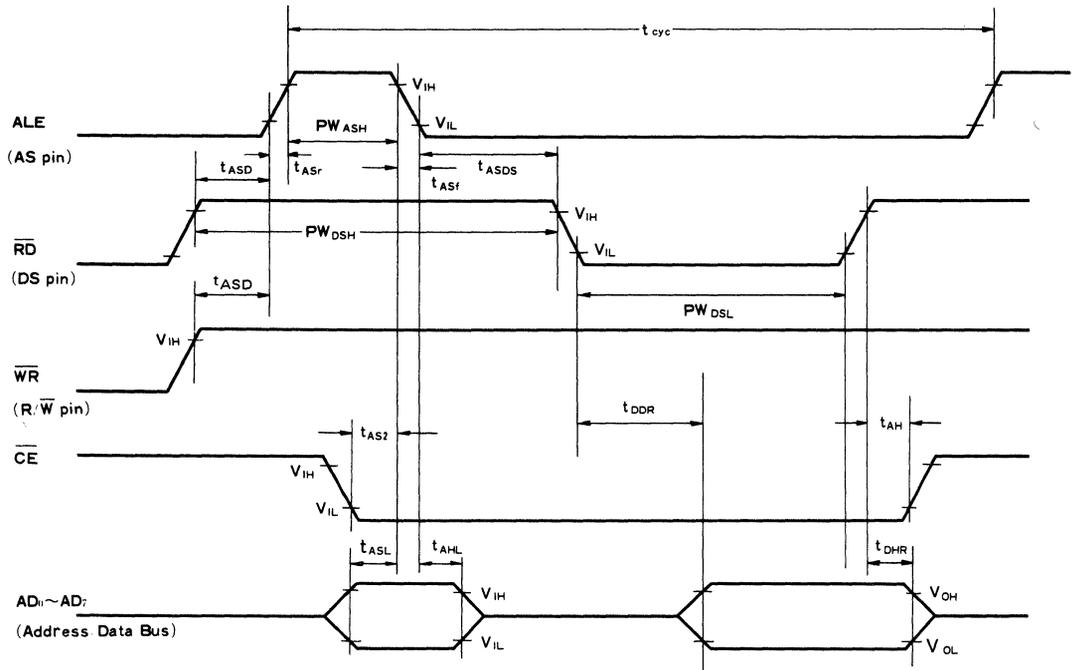


Figure 2 Read Timing (8085 Family)

(NOTE) $V_{IH} = V_{OH} = V_{CC} - 2.0V$
 $V_{IL} = 0.7V, V_{OL} = 0.5V$

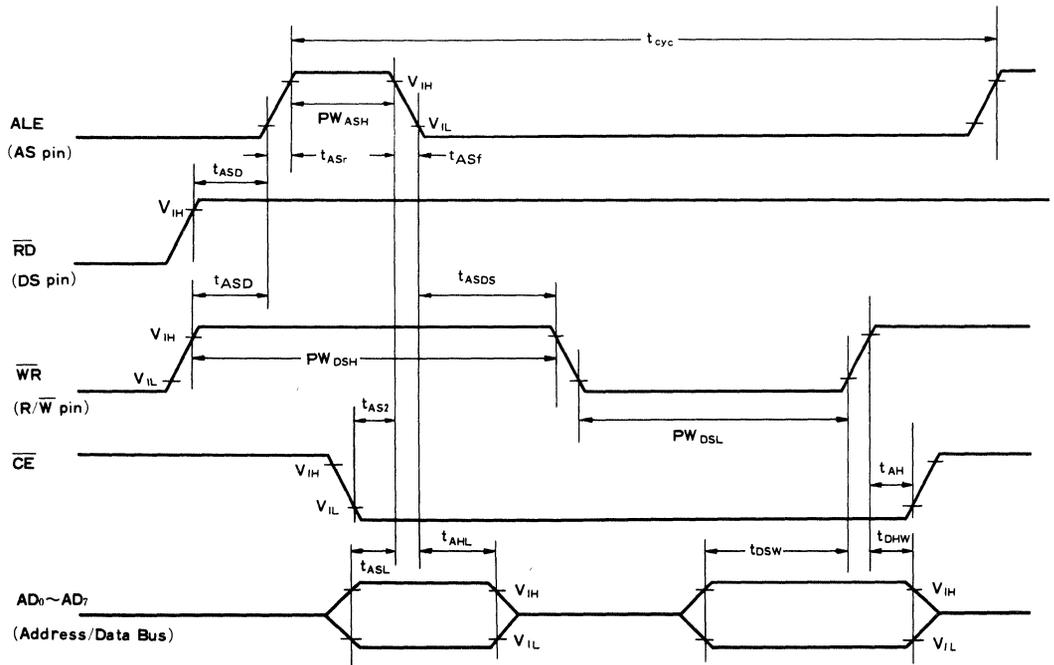


Figure 3 Write Timing (8085 Family)

(NOTE) $V_{IH} = V_{CC} - 2.0V$
 $V_{IL} = 0.7V$

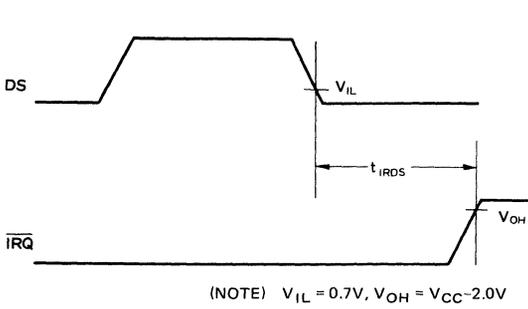


Figure 4 \overline{IRQ} Release Delay (from DS)

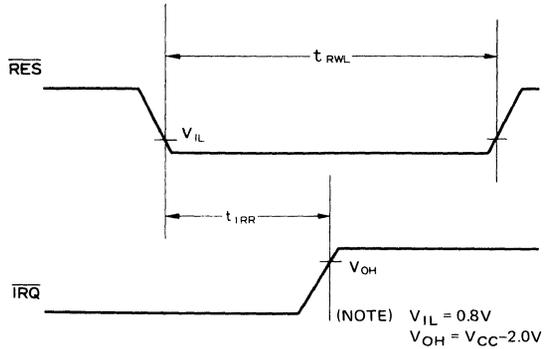
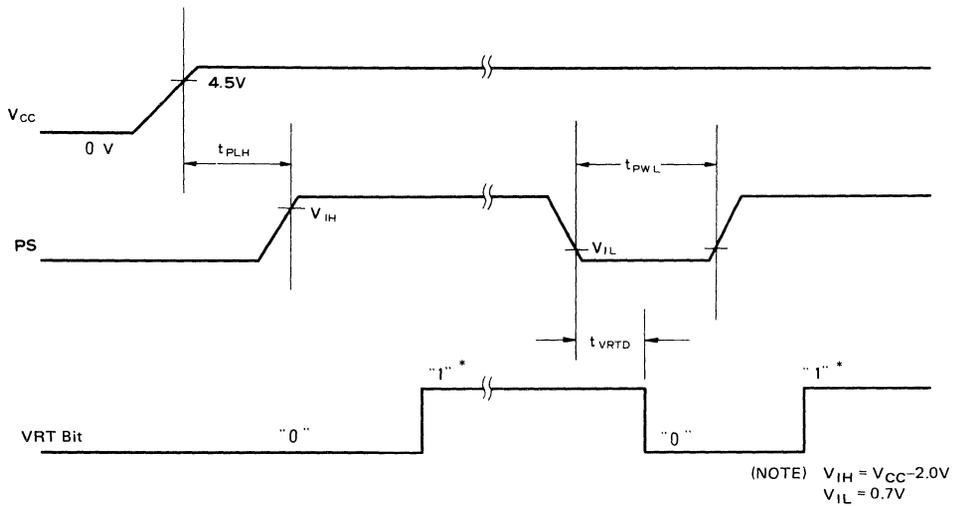


Figure 5 \overline{IRQ} Release Delay (from \overline{RES})



* The VRT bit is set to a "1" by reading control register #D. There is no additional way to clear the VRT bit.

Figure 6 VRT Bit Clear Timing

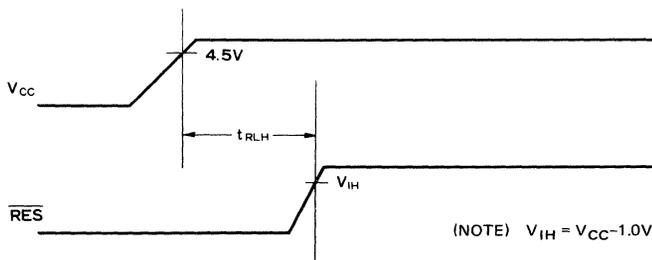
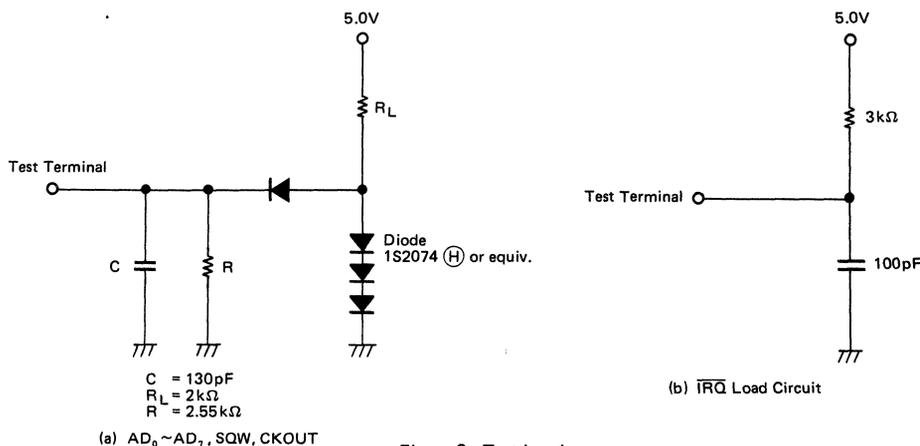


Figure 7 \overline{RES} Release Delay



- BATTERY BACKED-UP OPERATION
- DEFINITION OF BATTERY BACKED-UP OPERATION
 - Active functions
 - (1) Clock function

- (2) Retention of RAM data
- (3) $\overline{RES}, \overline{IRQ}, CKFS, CKOUT, PS, SQW$ functions
- Inactive functions
 - (1) Data bus read/write operation

● BATTERY BACKED-UP ELECTRICAL CHARACTERISTICS ($V_{SS} = 0V, T_a = 0 \sim +70^\circ C$, unless otherwise noted.)

Item	Symbol	Test Condition	min	typ	max	Unit	
Supply Voltage	V_{CCL}		2.7	—	4.5	V	
Supply Current	Crystal Oscillation	$V_{CCL} = 3.0V$ SQW : disable CKOUT : fosc (No load)	4MHz	—	—	600	μA
			1MHz	—	—	350	μA
	32kHz		—	50	100	μA	
	External Clock	$V_{CCL} = 3.0V$ SQW : disable CKOUT : fosc (No load)	4MHz	—	—	500	μA
1MHz			—	—	150	μA	
32kHz	—		30	70	μA		
Battery Backed-up Transit Setup Time	t_{CE}	Fig. 9	0	—	—	ns	
Operation Recovery Time	t_R		t_{cyc}	—	—	ns	
Supply Voltage Fall Time	t_{pf}		300	—	—	μs	
Supply Voltage Rise Time	t_{pr}		300	—	—	μs	
Input "High" Voltage	V_{IHL}	$V_{CCL} = 2.7V \sim 3.5V$	\overline{CE}, PS	$0.7 \times V_{CCL}$	—	V_{CCL}	V
			CKFS	2.5	—	V_{CCL}	V
		$V_{CCL} = 3.5V \sim 4.5V$	RES	$0.8 \times V_{CCL}$	—	V_{CCL}	V
			OSC ₁	$0.8 \times V_{CCL}$	—	V_{CCL}	V
Input "Low" Voltage	V_{ILL}		CKFS, PS	-0.3	—	0.5	V
			RES	-0.3	—	0.5	V
			OSC ₁	-0.3	—	0.5	V
Output "High" Voltage	V_{OHL}	$I_{OH} = -800\mu A$	SQW, CKOUT	$0.8 \times V_{CCL}$	—	—	V
Output "Low" Voltage	V_{OLL}	$I_{OL} = 800\mu A$	SQW, CKOUT	—	—	0.5	V
			\overline{IRQ}	—	—	0.5	V

* The time-base frequency to be used needs to be chosen in Register A.

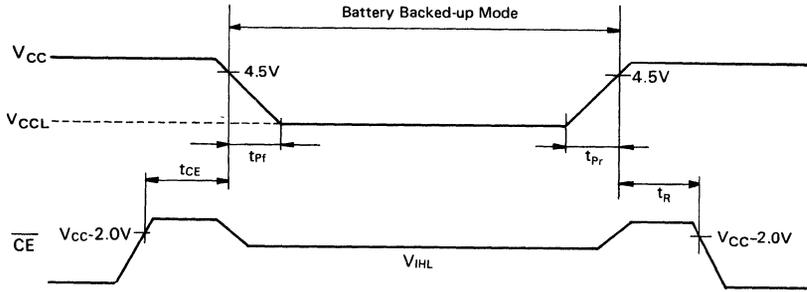


Figure 9 Battery Backed-up Timing

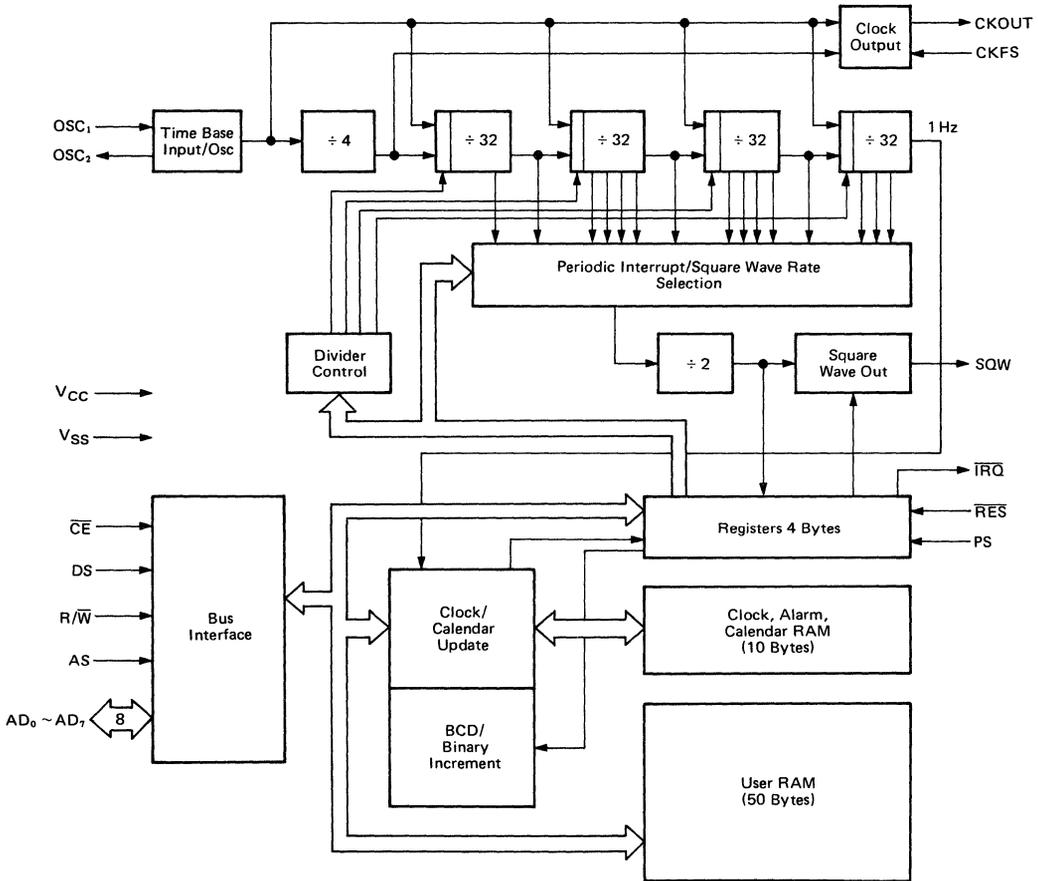


Figure 10 Block Diagram

■ CRYSTAL OSCILLATION CIRCUIT

The on-chip oscillator is designed for a parallel resonant crystal at 4.194304 MHz or 1.048576 MHz or 32.768 kHz frequencies. The crystal connections are shown in Figure 11.

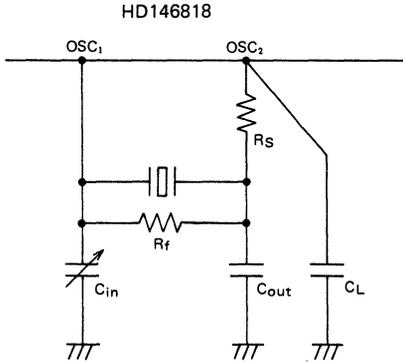


Figure 11 Crystal Oscillator Connection

■ NOTE FOR BOARD DESIGN OF THE OSCILLATION CIRCUIT

In designing the board, the following notes should be taken when the crystal oscillator is used.

- (1) Crystal oscillator, load capacity C_{in} , C_{out} , C_L and R_f , R_S must be placed near the LSI as much as possible. [Normal oscillation may be disturbed when external noise is induced to pin 2 and 3.]

Table 1 Oscillator Circuit Parameters

Parameter	f_{osc} 4.194304 MHz	1.048576 MHz	32.768 kHz
R_S	—	—	150 k Ω
R_f	150 k Ω	150 k Ω	5.6 M Ω
C_{in}	22 pF	33 pF	15 pF
C_{out}	22 pF	33 pF	33 pF
C_L	—	—	33 pF
CI	80 Ω (max)	700 Ω (max)	40 k Ω (max)

- (NOTE)
- 1. R_S , C_L are used for 32.768 kHz only.
 - 2. Capacitance (C_{in}) should be adjusted to accurate frequency. Parameters listed above are applied to the supply current measurement (See table of DC CHARACTERISTICS).
 - 3. CI: Crystal Impedance

- (2) Pin 3 signal line should be wired apart from pin 4 signal line as much as possible. Don't wire them in parallel, or normal oscillation may be disturbed when this signal is feedbacked to OSC_1 .
- (3) A signal line or a power source line must not cross or go near the oscillation circuit line as shown in the right figure to prevent the induction from these lines and perform the correct oscillation. The resistance among OSC_1 , OSC_2 and other pins should be over 10M Ω .

The following design must be avoided.

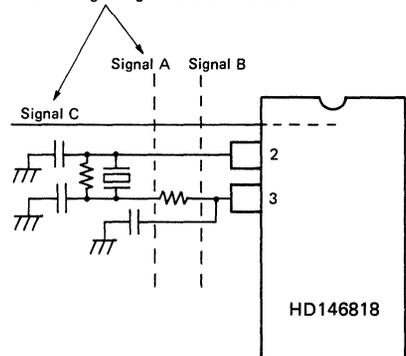
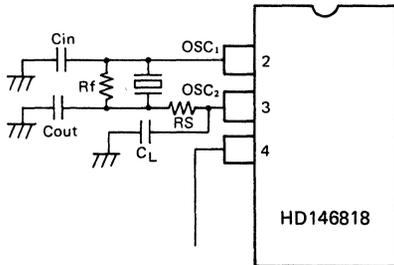


Figure 12 Note for Board Design of the Oscillation Circuit

■ INTERFACE CIRCUIT FOR HD6801, HD6301 AND 8085 PROCESSOR

HD146818 has a new interface circuit which permits the HD146818 to be directly interfaced with many type of multiplexed bus microprocessor such as HD6801, HD6301 and 8085 etc.

Figure 13 shows the bus control circuit. This circuit automatically selects the processor type by using AS/ALE to latch the state of DS/RD pin. Since DS is always "Low" and RD is always "High during AS/ALE, the latch automatically indicates which processor type is connected.

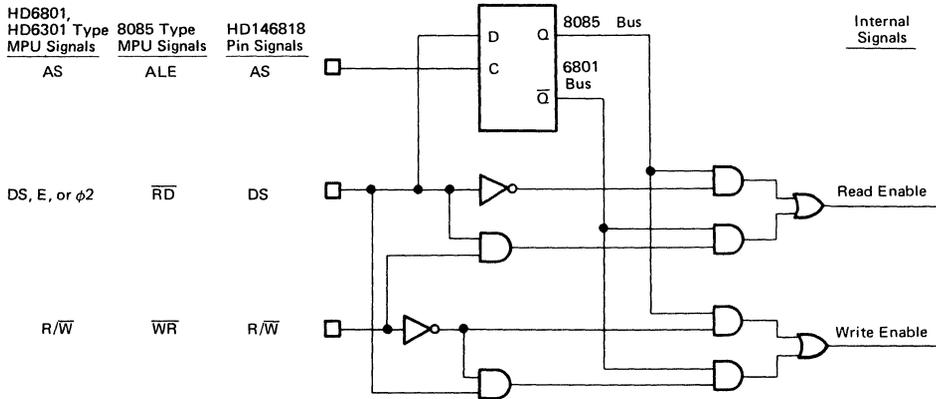


Figure 13 Functional Diagram of the Bus Control Circuit

■ ADDRESS MAP

Figure 14 shows the address map of the HD146818. The memory consists of 50 general purpose RAM bytes, 10 RAM bytes which normally contain the time, calendar, and alarm data, and four control and status bytes. All 64 bytes are directly readable and writable by the processor program except Registers C and D which are read only. Bit 7 of Register A and the seconds byte are also read only. Bit 7, of the second byte, always reads "0". The contents of the four control and status registers are described in the Register section.

• Time, Calendar, and Alarm Locations

The processor program obtains time and calendar information by reading the appropriate locations. The program

may initialize the time, calendar, and alarm by writing to these RAM locations. The contents of the 10 time, calendar, and alarm byte may be either binary or binary-coded decimal (BCD).

Before initializing the internal registers, the SET bit in Register B should be set to a "1" to prevent time/calendar updates from occurring. The program initializes the 10 locations in the selected format (binary or BCD), then indicates the format in the data mode (DM) bit of Register B. All 10 time, calendar, and alarm bytes must use the same data mode, either binary or BCD. The SET bit may now be cleared to allow updates. Once initialized the real-time clock makes all updates in the selected data mode. The data mode cannot be changed without reinitializing the 10 data bytes.

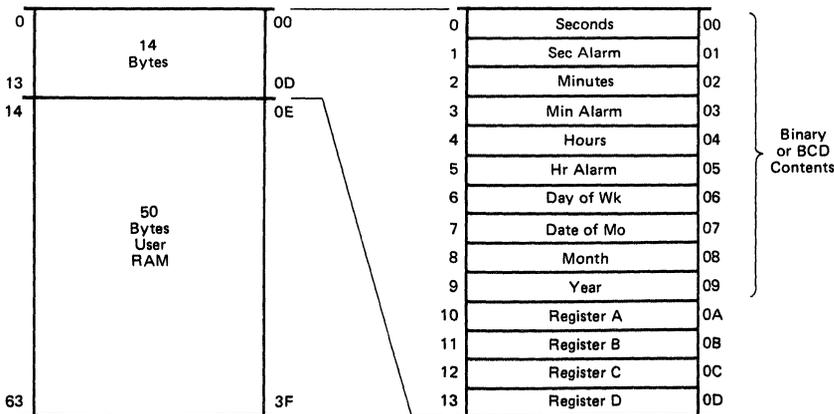


Figure 14 Address Map

Table 2 shows the binary and BCD formats of the 10 time, calendar, and alarm locations. The 24/12 bit in Register B establishes whether the hour locations represent 1-to-12 or 0-to-23. The 24/12 bit cannot be changed without reinitializing the hour locations. When the 12-hour format is selected the high-order bit of the hours byte represents PM when it is a "1".

The time, calendar, and alarm bytes are not always accessible by the processor program. Once-per-second the 10 bytes are switched to the update logic to be advanced by one second and to check for an alarm condition. If any of the 10 bytes are read at this time, the data outputs are undefined. The update lockout time is 248 μs at the 4.194304 MHz and 1.048567 MHz time bases and 1948 μs for the 32.768 kHz time base. The Update Cycle section shows how to accommodate

the update cycle in the processor program.

The three alarm bytes may be used in two ways. When the program inserts an alarm time in the appropriate hours, minutes, and seconds alarm locations, the alarm interrupt is initiated at the specified time each day if the alarm enable bit is "1". The alternate usage is to insert a "don't care" state in one or more of three alarm bytes. The "don't care" code is any hexadecimal byte from C0 to FF. That is, the two most-significant bits of each byte, when set to "1", create a "don't care" situation. An alarm interrupt each hour is created with a "don't care" code in the hours alarm location. Similarly, an alarm is generated every minute with "don't care" codes in the hours and minutes alarm bytes. The "don't care" codes in all three alarm bytes create an interrupt every second.

Table 2 Time, Calendar, and Alarm Data Modes

Address Location	Function	Decimal Range	Range		Example*	
			Binary Data Mode	BCD Data Mode	Binary Data Mode	BCD Data Mode
0	Seconds	0 ~ 59	\$00 ~ \$3B	\$00 ~ \$59	15	21
1	Seconds Alarm	0 ~ 59	\$00 ~ \$3B	\$00 ~ \$59	15	21
2	Minutes	0 ~ 59	\$00 ~ \$3B	\$00 ~ \$59	3A	58
3	Minutes Alarm	0 ~ 59	\$00 ~ \$3B	\$00 ~ \$59	3A	58
4	Hours (12 Hour Mode)	1 ~ 12	\$01 ~ \$0C (AM) and \$81 ~ \$8C (PM)	\$01 ~ \$12 (AM) and \$81 ~ \$92 (PM)	05	05
	Hours (24 Hour Mode)	0 ~ 23	\$00 ~ \$17	\$00 ~ \$23	05	05
5	Hours Alarm (12 Hour Mode)	1 ~ 12	\$01 ~ \$0C (AM) and \$81 ~ \$8C (PM)	\$01 ~ \$12 (AM) and \$81 ~ \$92 (PM)	05	05
	Hours Alarm (24 Hour Mode)	0 ~ 23	\$00 ~ \$17	\$00 ~ \$23	05	05
6	Day of the Week Sunday = 1	1 ~ 7	\$01 ~ \$07	\$01 ~ \$07	05	05
7	Day of the Month	1 ~ 31	\$01 ~ \$1F	\$01 ~ \$31	0F	15
8	Month	1 ~ 12	\$01 ~ \$0C	\$01 ~ \$12	02	02
9	Year	0 ~ 99**	\$00 ~ \$63	\$00 ~ \$99	4F	79

* Example: 5:58:21 Thursday 15th February 1979

** Set the lower two digits of year in AD. If this number is multiple of 4, update applied to leap year is excuted.

● **Static CMOS RAM**

The 50 general purpose RAM bytes are not dedicated within the HD146818. They can be used by the processor program, and are fully available during the update cycle.

When time and calendar information must use battery back-up, very frequently there is other non-volatile data that must be retained when main power is removed. The 50 user RAM bytes serve the need for low-power CMOS battery-backed storage, and extend the RAM available to the program.

When further CMOS RAM is needed, additional HD146818s may be included in the system. The time/calendar functions may be disabled by holding the dividers, in Register A, in the reset state by setting the SET bit in Register B or by removing the oscillator. Holding the dividers in reset prevents interrupts or SQW output from operating while setting the SET bit allows these functions to occur. With the dividers clear, the available user RAM is extended to 59 bytes. Bit 7 of Register A, Registers C and D, and the high-order Bit of the seconds byte cannot effectively be used as general purpose RAM.

■ **INTERRUPTS**

The RTC plus RAM includes three separate fully automatic sources of interrupts to the processor. The alarm interrupt may be programmed to occur at rates from once-per-second to one-a-day. The periodic interrupt may be selected for rates from half-a-second to 30.517 μs. The update-ended interrupt may be used to indicate to the program that an up-date cycle is completed. Each of these independent interrupt conditions are described in greater detail in other sections.

The processor program selects which interrupts, if any, it wishes to receive. Three bits in Register B enable the three interrupts. Writing a "1" to a interrupt-enable bit permits that interrupt to be initiated when the event occurs. A "0" in the interrupt-enable bit prohibits the \overline{IRQ} pin from being asserted due to the interrupt cause.

If an interrupt flag is already set when the interrupt becomes enabled, the \overline{IRQ} pin is immediately activated, though the interrupt initiating the event may have occurred much earlier. Thus, there are cases where the program should clear such

earlier initiated interrupts before first enabling new interrupts.

When an interrupt event occurs a flag bit is set to a "1" in Register C. Each of the three interrupt sources have separate flag bits in Register C, which are set independent of the state of the corresponding enable bits in Register B. The flag bit may be used with or without enabling the corresponding enable bits.

In the software scanned case, the program does not enable the interrupt. The "interrupt" flag bit becomes a status bit, which the software interrogates, when it wishes. When the software detects that the flag is set, it is an indication to software that the "interrupt" event occurred since the bit was last read.

However, there is one precaution. The flag bits in Register C are cleared (record of the interrupt event is erased) when Register C is read. Double latching is included with Register C so the bits which are set are stable throughout the read cycle. All bits which are high when read by the program are cleared, and new interrupts (on any bits) are held until after the read cycle. One, two, or three flag bits may be found to be set when Register C is read. The program should inspect all utilized flag bits every time Register C is read to insure that no interrupts are lost.

The second flag bit usage method is with fully enabled interrupts. When an interrupt-flag bit is set and the corresponding interrupt-enable bit is also set, the $\overline{\text{IRQ}}$ pin is asserted "Low". $\overline{\text{IRQ}}$ is asserted as long as at least one of the three interrupt sources has its flag and enable bits both set. The

$\overline{\text{IRQ}}$ bit in Register C is a "1" whenever the $\overline{\text{IRQ}}$ pin is being driven "Low".

The processor program can determine that the RTC initiated the interrupt by reading Register C. A "1" in bit 7 (IRQF bit) indicates that one of more interrupts have been initiated by the part. The act of reading Register C clears all the then-active flag bits, plus the IRQF bit. When the program finds IRQF set, it should look at each of the individual flag bits in the same byte which have the corresponding interrupt-mask bits set and service each interrupt which is set. Again, more than one interrupt-flag bit may be set.

■ DIVIDER STAGES

The HD146818 has 22 binary-divider stages following the time base as shown in Figure 10. The output of the dividers is a 1 Hz signal to the update-cycle logic. The dividers are controlled by three divider bus (DV2, DV1, and DV0) in Register A.

● Divider Control

The divider-control bits have three uses, as shown in Table 3. Three usable operating time bases may be selected (4.194304 MHz, 1.048576 MHz, or 32.768 kHz). The divider chain may be held reset, which allows precision setting of the time. When the divider is changed from reset to an operating time base, the first update cycle is one second later. The divider-control bits are also used to facilitate testing the HD146818.

Table 3 Divider Configurations

Time-Base Frequency	Divider Bits Register A			Operation Mode	Divider Reset	Bypass First N-Divider Bits
	DV2	DV1	DV0			
4.194304 MHz	0	0	0	Yes	—	N = 0
1.048576 MHz	0	0	1	Yes	—	N = 2
32.768 kHz	0	1	0	Yes	—	N = 7
Any	1	1	0	No	Yes	—
Any	1	1	1	No	Yes	—

(NOTE) Other combinations of divider bits are used for test purposes only.

● Square-Wave Output Selection

Fifteen of the 22 divider taps are made available to a 1-of-15 selector as shown in Figure 10. The first purpose of selecting a divider tap is to generate a square-wave output signal in the SQW pin. Four bits in Register A establish the square-wave frequency as listed in Table 4. The SQW frequency selection shares the 1-of-15 selector with periodic interrupts.

Once the frequency is selected, the output of the SQW pin may be turned on and off under program control with the square-wave enable (SQWE) bit in Register B. Altering the divider, square-wave output selection bits, or the SQW output-enable bit may generate an asymmetrical waveform at the time of execution. The square-wave output pin has a number of potential uses. For example, it can serve as a frequency standard for external use, a frequency synthesizer, or could be used to generate one or more audio tones under program control.

● Periodic Interrupt Selection

The periodic interrupt allows the $\overline{\text{IRQ}}$ pin to be triggered from once every 500 ms to once every 30.517 μs . The periodic interrupt is separate from the alarm interrupt which may be output from once-per-second to once-per-day.

Table 4 shows that the periodic interrupt rate is selected with the same Register A bits which select the square-wave frequency. Changing one also changes the other. But each function may be separately enabled so that a program could switch between the two features or use both. The SQW pin is enabled by the SQWE bit. Similarly the periodic interrupt is enabled by the PIE bit in Register B.

Periodic interrupt is usable by practically all real-time systems. It can be used to scan for all forms of input from contact closures to serial receive bits or ties. It can be used in multiplexing displays or with software counters to measure inputs, create output intervals, or await the next needed software function.

Table 4 Periodic Interrupt Rate and Square Wave Output Frequency

Rate Select Control Register 1				4.194304 or 1.048576 MHz Time Base		32.768 kHz Time Base	
				Periodic Interrupt Rate t_{PI}	SQW Output Frequency	Periodic Interrupt Rate t_{PI}	SQW Output Frequency
RS3	RS2	RS1	RS0				
0	0	0	0	None	None	None	None
0	0	0	1	30.517 μ s	32.768 kHz	3.90625 ms	256 Hz
0	0	1	0	61.035 μ s	16.384 kHz	7.8125 ms	128 Hz
0	0	1	1	122.070 μ s	8.192 kHz	122.070 μ s	8.192 kHz
0	1	0	0	244.141 μ s	4.096 kHz	244.141 μ s	4.096 kHz
0	1	0	1	488.281 μ s	2.048 kHz	488.281 μ s	2.048 kHz
0	1	1	0	976.562 μ s	1.024 kHz	976.562 μ s	1.024 kHz
0	1	1	1	1.953125 ms	512 Hz	1.953125 ms	512 Hz
1	0	0	0	3.90625 ms	256 Hz	3.90625 ms	256 Hz
1	0	0	1	7.8125 ms	128 Hz	7.8125 ms	128 Hz
1	0	1	0	15.625 ms	64 Hz	15.625 ms	64 Hz
1	0	1	1	31.25 ms	32 Hz	31.25 ms	32 Hz
1	1	0	0	62.5 ms	16 Hz	62.5 ms	16 Hz
1	1	0	1	125 ms	8 Hz	125 ms	8 Hz
1	1	1	0	250 ms	4 Hz	250 ms	4 Hz
1	1	1	1	500 ms	2 Hz	500 ms	2 Hz

• Initialization of the Time and the Start Sequence

The first update of the time occurs about 500ms later after the SET bit of control register B is reset. So keep followings in mind when initializing and adjusting the time.

Procedure of time initialization

- (1) Set the SET bit of control register B. (SET = "1")
- (2) Set "1" into all the DV0, 1, 2 bits of control register A. (DV0 = DV1 = DV2 = "1")
- (3) Set the time and calendar to each RAM.
- (4) Set the frequency in use into DV0, 1 and DV2.
- (5) Reset the SET bit. (SET = "0")

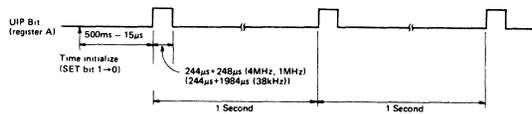


Figure 15 Time Initialization and the First Update

Restriction on Time-of-day and Calendar Initialization

There is a case in HD146818 (RTC) that update is not executed correctly if time of day and calendar shown below are initialized. Therefore, initialize the RTC without using time of

day shown below.

Calendar, Time of day & Status after Update	Examples
If 29th 23:59:59 in all the months is initialized, update to 1st in the next month is executed. (Jan. - Dec. However except for Feb. 29th in leap year)	Mar. 29th → Apr. 1st
If 30th 23:59:59 in Apr., June, Sept., and Nov. is initialized, update to 31st in each month is executed.	Apr. 30th → Apr. 31st
If Feb. 28th 23:59:59 (not in leap year) is initialized, update to Feb. 29th is executed.	Feb. 28th, 1983 → Feb. 29th, 1983
If Feb. 28th 23:59:58 (in leap year) is initialized, update to Mar. 1st is executed.	Feb. 28th, 1984 → Mar. 1st, 1984

■ UPDATE CYCLE

The HD146818 executes an update cycle once-per-second, assuming one of the proper time bases is in place, the divider is not clear, and the SET bit in Register B is clear. The SET bit in the "1" state permits the program to initialize the time and calendar bytes by stopping an existing update and preventing a new one from occurring.

The primary function of the update cycle is to increment the seconds byte, check for overflow, increment the minutes byte when appropriate and so forth through to the year of the century byte. The update cycle also compares each alarm byte with the corresponding time byte and issues an alarm if a match or if a "don't care" code (11XXXXXX) is present in all three positions.

With a 4.194304 MHz or 1.048576 MHz time base the up-

date cycle takes 248 μ s while a 32.768 kHz time base update cycle takes 1984 μ s. During the update cycle, the time, calendar, and alarm bytes are not accessible by the processor program. The HD146818 protects the program from reading transitional data. This protection is provided by switching the time, calendar, and alarm portion of the RAM off the microprocessor bus during the entire update cycle. If the processor reads these RAM locations before the update is complete the output will be undefined. The update in progress (UIP) status bit is set during the interval.

A program which randomly accesses the time and date information finds data unavailable statistically once every 4032 attempts. Three methods of accommodating nonavailability during update are usable by the program. In discussing the three methods it is assumed that at random points user programs are able to call a subroutine to obtain the time of day.

The first method of avoiding the update cycle uses the update-ended interrupt. If enabled, an interrupt occurs after every update cycle which indicates that over 999 ms are available to read valid time and date information. During this time a display could be updated or the information could be transferred to continuously available RAM. Before leaving the interrupt service routine, the IRQF bit in Register C should be cleared.

The second method uses the update-in-progress bit (UIP) in Register A to determine if the update cycle is in progress or not. The UIP bit will pulse once-per-second. Statistically, the UIP bit will indicate that time and date information is unavailable once every 2032 attempts. After the UIP bit goes "1", the update cycle begins 244 μ s later. Therefore, if a "0" is read on the UIP bit, the user has at least 244 μ s before the time/calendar data will be changed. If a "1" is read in the UIP bit, the time/calendar data may not be valid. The user should avoid interrupt service routines that would cause the

time needed to read valid time/calendar data to exceed 244 μ s.

The third method uses a periodic interrupt to determine if an update cycle is in progress. The UIP bit in Register A is set "1" between the setting of the PF bit in Register C (see Figure 16) Periodic interrupts that occur at a rate of greater than $t_{BUC} + t_{UC}$ allow valid time and date information to be read at each occurrence of the periodic interrupt. The reads should be completed within $(t_{PI} \div 2) + t_{BUC}$ to insure that data is not read during the update cycle.

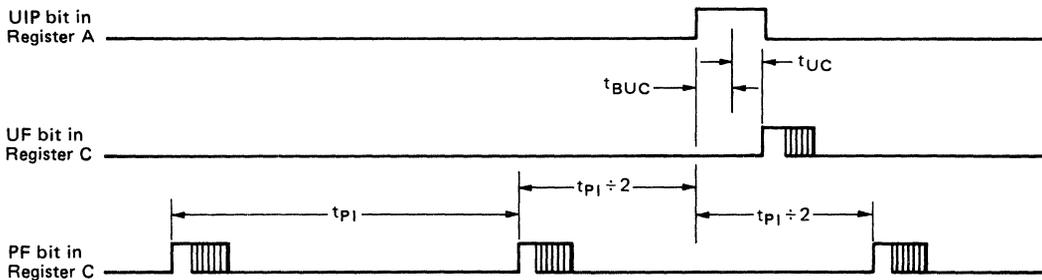
■ POWER-DOWN CONSIDERATIONS

In most systems, the HD146818 must continue to keep time when system power is removed. In such systems, a conversion from system power to an alternate power supply, usually a battery, must be made. During the transition from system to battery power, the designer of a battery backed-up RTC system must protect data integrity, minimize power consumption, and ensure hardware reliability according to the specification described in the section regarding Battery Backed-up operation.

The chip enable (\overline{CE}) pin controls all bus inputs (R/ \overline{W} , DS, AS, AD₀ ~ AD₇). \overline{CE} , when negated, disallows any unintended modification of the RTC data by the bus. \overline{CE} also reduces power consumption by reducing the number of transitions seen internally.

Power consumption may be further reduced by removing resistive and capacitive loads from the clock out (CKOUT) pin and the squarewave (SQW) pin.

During and after the power source conversion, the V_{IN} maximum specification must never be exceeded. Failure to meet the V_{IN} maximum specification can cause a virtual SCR to appear which may result in excessive current drain and destruction of the part.



- t_{PI} = Periodic Interrupt Time Interval (500 ms, 250 ms, 125 ms, 62.5 ms, etc.)
- t_{UC} = Update Cycle Time (248 μ s or 1984 μ s)
- t_{BUC} = Delay Time Before Update Cycle (244 μ s)

Figure 16 Update-Ended and Periodic Interrupt Relationship

■ SIGNAL DESCRIPTIONS

The block diagram in Figure 10, shows the pin connection with the major internal functions of the HD146818 Real-Time Clock plus RAM. The following paragraphs describe the function of each pin.

● **V_{CC}, V_{SS}**

DC power is provided to the part on these two pins, V_{CC} being the most positive voltage. The minimum and maximum voltages are listed in the Electrical Characteristics tables.

● **OSC₁, OSC₂ – Time Base (Inputs)**

The time base for the time functions may be an external signal or the crystal oscillator. External square waves at 4.194304 MHz, 1.048576 MHz, or 32.768 kHz may be connected to OSC₁ as shown in Figure 17. The time-base frequency to be used is chosen in Register A.

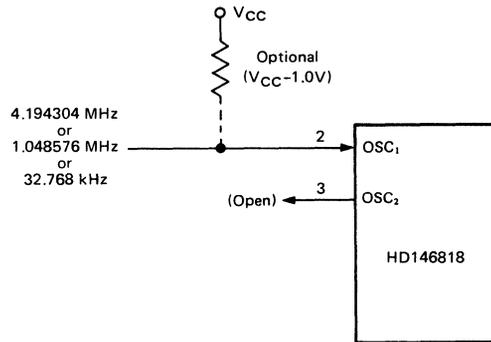


Figure 17 External Time-Base Connection

Table 5 Clock Output Frequencies

Time Base (OSC ₁) Frequency	Clock Frequency Select Pin (CKFS)	Clock Frequency Output Pin (CKOUT)
4.194304 MHz	“High”	4.194304 MHz
4.194304 MHz	“Low”	1.048576 MHz
1.048576 MHz	“High”	1.048576 MHz
1.048576 MHz	“Low”	262.144 kHz
32.768 kHz	“High”	32.768 kHz
32.768 kHz	“Low”	8.192 kHz

● **SQW – Square Wave (Output)**

The SQW pin can output a signal one of 15 of the 22 internal-divider stages. The frequency and output enable of the SQW may be altered by programming Register A, as shown in Table 4. The SQW signal may be turned on and off using a bit in Register B.

● **AD₀ ~ AD₇ – Multiplexed Bidirectional Address/Data Bus**

Multiplexed bus processors save pins by presenting the address during the first portion of the bus cycle and using the same pins during the second portion for data. Address-then-data multiplexing does not slow the access time of the HD146818 since the bus reversal from address to data is occurring during the internal RAM access time.

The address must be valid just prior to the fall of AS/ALE

The on-chip oscillator is designed for a parallel resonant crystal at 4.194304 MHz or 1.048576 MHz or 32.768 kHz frequencies. The crystal connections are shown in Figure 11.

● **CKOUT – Clock Out (Output)**

The CKOUT pin is an output at the time-base frequency divided by 1 or 4. A major use for CKOUT is as the input clock to the microprocessor; thereby saving the cost of a second crystal. The frequency of CKOUT depends upon the time-base frequency and the state of the CKFS pin as shown in Table 5.

● **CKFS – Clock Out Frequency Select (Input)**

The CKOUT pin is an output at the time-base frequency divided by 1 or 4. CKFS tied to V_{CC} causes CKOUT to be the same frequency as the time base at the OSC₁ pin. When CKFS is at V_{SS}, CKOUT is the OSC₁ time-base frequency divided by four. Table 5 summarizes the effect of CKFS.

at which time the HD146818 latches the address from AD₀ to AD₅. Valid write data must be presented and held stable during the latter portion of the DS or WR pulses. In a read cycle, the HD146818 outputs 8 bits of data during the latter portion of the DS or RD pulses, then ceases driving the bus (returns the output drivers to three-state) when DS falls in the HD6801, HD6301 case or RD rises in the other case.

● **AS – Multiplexed Address Strobe (Input)**

A positive going multiplexed address strobe pulse serves to demultiplex the bus. The falling edge of AS or ALE causes the address to be latched within the HD146818. The bus control circuit in the HD146818 also latches the state of the DS pin with the falling edge of AS or ALE.

● **DS – Data Strobe or Read (Input)**

The DS pin has two interpretations via the bus control circuit. When emanating from 6801 family type processor, DS is a positive pulse during the latter portion of the bus cycle, and is variously called DS (data strobe), E (enable), and φ₂ (φ₂ clock). During read cycles, DS signifies the time that the RTC is to drive the bidirectional bus. In write cycles, the trailing edge of DS causes the Real-Time Clock plus RAM to latch the written data.

The second interpretation of DS is that of RD, MEMR, or I/OR emanating from the 8085 type processor. In this case, DS identifies the time period when the real-time clock plus RAM drives the bus with read data. This interpretation of

DS is also the same as an output-enable signal on a typical memory.

The bus control circuit, within the HD146818, latches the state of the DS pin on the falling edge of AS/ALE. When 6801 mode. DS must be "Low" during AS/ALE, which is the case with 6801 family multiplexed bus processors. To insure the 8085 mode of this circuit the DS pin must remain "High" during the time AS/ALE is "High".

• **R/W – Read/Write (Input)**

The bus control circuit treats the R/W pin in one of two ways. When 6801 family type processor is connected, R/W is a level which indicates whether the current cycle is a read or write. A read cycle is indicated with a "High" level on R/W while DS is "High", whereas a write cycle is a "Low" on R/W during DS

The second interpretation of R/W is as a negative write pulse, WR, MEMW, and I/OW from 8085 type processors. This circuit in this mode gives R/W pin the same meaning as the write (W) pulse on many generic RAMs.

• **CE – Chip Enable (Input)**

The chip-enable (CE) signal must be asserted ("Low") for a bus cycle in which the HD146818 is to be accessed. CE is not latched during DS and AS (in the 6801 case) and during RD and WR (in the 8085 case). Bus cycles which take place without asserting CE cause no actions to take place within the HD146818. When CE is "High", the multiplexed bus output is in a high-impedance state.

When CE is "High", all address, data, DS, and R/W inputs from the processor are disconnected within the HD146818.

This permits the HD146818 to be isolated from a powered-down processor. When CE is held "High", an unpowered device cannot receive power through the input pins from the real-time clock power source. Battery power consumption can thus be reduced by using a pullup resistor or active clamp on CE when the main power is off.

• **IRQ – Interrupt Request (Output)**

The IRQ pin is an active "Low" output of the HD146818 that may be used as an interrupt input to a processor. The IRQ output remains "Low" as long as the status bit causing the interrupt is present and the corresponding interrupt-enable bit is set. To clear the IRQ pin, the processor program normally reads Register C. The RES pin also clears pending interrupts.

When no interrupt conditions are present, the IRQ level is in the high-impedance state. Multiple interrupting devices may thus be connected to an IRQ bus with one pullup at the processor.

• **RES – Reset (Input)**

The RES pin does not affect the clock, calendar, or RAM functions. On powerup, the RES pin must be held "Low" for the specified time, t_{RLH}, in order to allow the power supply to stabilize, Figure 18 shows a typical representation of the RES pin circuit.

When RES is "Low" the following occurs:

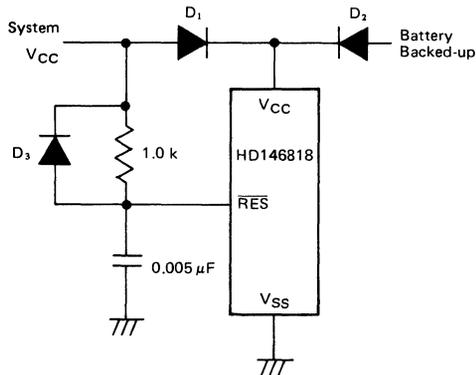
- a) Periodic Interrupt Enable (PIE) bit is cleared to "0".
- b) Alarm Interrupt Enable (AIE) bit is cleared to "0".
- c) Update ended interrupt Enable (UIE) bit is cleared to "0".
- d) Update ended Interrupt Flag (UF) bit is cleared to "0".
- e) Interrupt Request status Flag (IRQF) bit is cleared to "0".
- f) Periodic Interrupt Flag (PF) bit is cleared to "0".

- g) Alarm Interrupt Flag (AF) bit is cleared to "0".
- h) IRQ pin is in high-impedance state, and
- i) Square Wave output Enable (SQWE) bit is cleared to "0".

• **PS – Power Sense (Input)**

The power-sense pin is used in the control of the valid RAM and time (VRT) bit in Register C. When the PS pin is "Low" the VRT bit is cleared to "0".

During powerup, the PS pin must be externally held "Low" for the specified time, t_{PLH}. As power is applied the VRT bit remain "Low" indicating that the contents of the RAM, time registers, and calendar are not guaranteed. When normal operation commences PS should be permitted to go "High". Output signal from external power sense circuit will be connected to this input.



(NOTE) If the RTC is isolated from the MPU or MCU power by a diode drop, care must be taken to meet V_{in} requirements.

Figure 18 Typical Powerup Delay Circuit for RES

■ **REGISTERS**

The HD146818 has four registers which are accessible to the processor program. The four registers are also fully accessible during the update cycle.

• **Register A (\$0A)**

MSB					LSB			Read/Write Register except UIP
b7	b6	b5	b4	b3	b2	b1	b0	
UIP	DV2	DV1	DV0	RS3	RS2	RS1	RS0	

UIP – The update in progress (UIP) bit is a status flag that may be monitored by the program. When UIP is a "1" the update

Table 6 Update Cycle Times

UIP Bit	Time Base (OSC ₁)	Update Cycle Time (t _{UC})	Minimum Time Before Update Cycle (t _{BUC})
1	4.194304 MHz	248 μs	—
1	1.048576 MHz	248 μs	—
1	32.768 kHz	1984 μs	—
0	4.194304 MHz	—	244 μs
0	1.048576 MHz	—	244 μs
0	32.768 kHz	—	244 μs

cycle is in progress or will soon begin. When UIP is a “0” the update cycle is not in progress and will not be for at least 244 μs (for all time bases). This is detailed in Table 6. The time, calendar, and alarm information in RAM is fully available to the program when the UIP bit is zero – it is not in transition. The UIP bit is a read-only bit, and is not affected by Reset. Writing the SET bit in Register B to a “1” inhibit any update cycle and then clear the UIP status bit.

DV2, DV1, DV0 – Three bits are used to permit the program to select various conditions of the 22-stage divider chain. The divider selection bits identify which of the three time-base frequencies is in use. Table 3 shows that time bases of 4.194304 MHz, 1.048576 MHz, and 32.768 kHz may be used. The divider selection bits are also used to reset the divider chain. When the time/calendar is first initialized, the program may start the divider at the precise time stored in the RAM. When the divider reset is removed the first update cycle begins half a second later. These three read/write bits are never modified by the RTC and are not affected by RES.

RS3, RS2, RS1, RS0 – The four rate selection bits select one of 15 taps on the 22-stage divider, or disable the divider output. The tap selected may be used to generate an output square wave (SQW pin) and/or a periodic interrupt. The program may do one of the following: 1) enable the interrupt with the PIE bit, 2) enable the SQW output pin with the SQWE bit, 3) enable both at the same time at the same rate, or 4) enable neither. Table 4 lists the periodic interrupt rates and the square-wave frequencies that may be chosen with the RS bits. These four bits are read/write bits which are not affected by RES and are never changed by the RTC.

● Register B (\$0B)

MSB								LSB		Read/Write Register
b7	b6	b5	b4	b3	b2	b1	b0			
SET	PIE	AIE	UIE	SQWE	DM	24/12	DSE			

SET – When the SET bit is a “0”, the update cycle functions normally by advancing the counts once-per-second. When the SET bit is written to a “1”, any update cycle in progress is aborted and the program may initialize the time and calendar bytes without an update occurring in the midst of initializing. SET is a read/write bit which is not modified by RES or internal functions of the HD146818.

PIE – The periodic interrupt enable (PIE) bit is a read/write bit which allows the periodic-interrupt flag (PF) bit to cause the IRQ pin to be driven “Low”. A program writes a “1” to the PIE bit in order to receive periodic interrupts at the rate specified by the RS3, RS2, RS1, and RS0 bits in Control Register A. A “0” in PIE blocks IRQ from being initiated by a periodic interrupt, but the periodic flag (PF) bit is still at the periodic rate. PIE is not modified by any internal HD146818 functions, but is cleared to “0” by a RES.

AIE – The alarm interrupt enable (AIE) bit is a read/write bit which when set to a “1” permits the alarm flag (AF) to assert IRQ. An alarm interrupt occurs for each second that the three time bytes equal the three alarm bytes (including a “don’t care” alarm code of binary 11XXXXXX). When the AIE bit is a “0”, the AF bit does not initiate an IRQ signal. The RES pin clears AIE to “0”. The internal functions do not affect

the AIE bit.

UIE – The UIE (update-ended interrupt enable) bit is a read/write bit which enables the update-end flage (UF) bit to assert IRQ. The RES pin going “Low” or the SET bit going “1” clears the UIE bit.

SQWE – When the square-wave enable (SQWE) bit is set to a “1” by the program, a square-wave signal at the frequency specified in the rate selection bits (RS3 to RS0) appears on the SQW pin. When the SQWE bit is set to a “0” the SQW pin is held “Low”. The state of SQWE is cleared by the RES pin. SQWE is a read/write bit.

DM – The data mode (DM) bit indicates whether time and calendar updates are to use binary or BCD formats. The DM bit is written by the processor program and may be read by the program, but is not modified by any internal functions or RES. A “1” in DM signifies binary data, while a “0” in DM specified binary-coded-decimal (BCD) data.

24/12 – The 24/12 control bit establishes the format of the hours bytes as either the 24-hour mode (a “1”) or the 12-hour mode (a “0”). This is a read/write bit, which is affected only by the software.

DSE – The daylight savings enable (DSE) bit is a read/write bit which allows the program to enable two special updates (when DSE is a “1”). On the last Sunday in April the time increments from 1:59:59 AM to 3:00:00 AM. On the last Sunday in October when the time first reaches 1:59:59 AM it changes to 1:00:00 AM. These special updates do not occur when the DSE bit is a “0”. DSE is not changed by any internal operations or reset.

● Register C (\$0C)

MSB							LSB		Read-Only Register
b7	b6	b5	b4	b3	b2	b1	b0		
IRQF	PF	AF	UF	0	0	0	0		

IRQF – The interrupt request flag (IRQF) is set to a “1” when one or more of the following are true:

- PF = PIE = “1”
- AF = AIE = “1”
- UF = UIE = “1”

i.e., $IRQF = PF \cdot PIE + AF \cdot AIE + UF \cdot UIE$

Any time the IRQF bit is a “1”, the IRQ pin is driven “Low”. All flag bits are cleared after Register C is read by the program or when the RES pin is low. A program write to Register C does not modify any of the flag bits.

PF – The periodic interrupt flag (PF) is a read-only bit which is set to a “1” when a particular edge is detected on the selected tap of the divider chain. The RS3 to RS0 bits establish the periodic rate. PF is set to a “1” independent of the state of the PIE bit. PF being a “1” initiates an IRQ signal and the IRQF bit when PIE is also a “1”. The PF bit is cleared by a RES or a software read of Register C.

AF – A “1” in the AF (alarm interrupt flag) bit indicates that the current time has matched the alarm time. A “1” in the AF causes the IRQ pin to go “Low”, and a “1” to appear in the IRQF bit, when the AIE bit also is a “1”. A RES or a read

of Register C clears AF.

UF – The update-ended interrupt flag (UF) bit is set after each update cycle. When the UIE bit is a “1”, the “1” in UF causes the IRQF bit to be a “1”, asserting \overline{IRQ} . UF is cleared by a Register C read or a \overline{RES} .

b3 to b0 – The unused bits of Status Register C are read as “0’s”. They can not be written.

● **Register D (\$0D)**

MSB							LSB	Read Only Register
b7	b6	b5	b4	b3	b2	b1	b0	
VRT	0	0	0	0	0	0	0	

VRT – The valid RAM and time (VRT) bit indicates the condition of the contents of the RAM, provided the power sense (PS) pin is satisfactorily connected. A “0” appears in the VRT bit when the power-sense pin is “Low”. The processor program can set the VRT bit when the time and calendar are initialized to indicate that the RAM and time are valid. The VRT is a read/only bit which is not modified by the \overline{RES} pin. The VRT bit can only be set by reading the Register D. For setting this bit, PS signal needs to be “High” level.

b6 to b0 – The remaining bits of Register D are unused. They cannot be written, but are always read as “0’s”.

■ **NOTE FOR USE**

Input Signal, which is not necessary for user’s application, should be used fixed to “High” or “Low” level. This is applicable to the following signal pins.

CKFS, PS

RESTRICTION ON HD146818 USAGE (1)

The daylight saving function can not be performed on the HD146818P (X type). So do not use this function for the system design.

< Type number > HD146818P (X type Marked as follows) X or RX



< Restriction on usage >

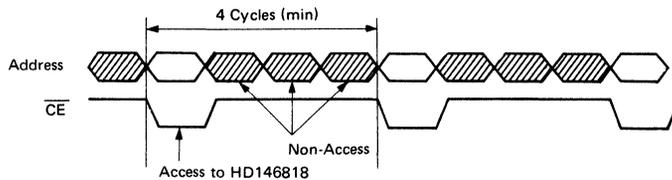
Please set "0" to DSE bit (Daylight Saving Enable bit) on initializing the control register B.
DSE = "1" is prohibited.

RESTRICTION ON HD146818 USAGE (2)

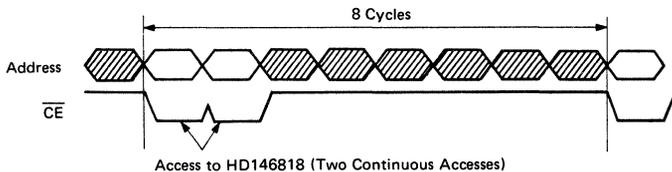
Access to HD146818 needs to be performed under following conditions.

- (i) Chip-enable (\overline{CE}) must be asserted to active "Low" level only when MPU performs read/write operation from/into internal RAM (Time and Calendar RAM, Control register, User RAM).
- (ii) User RAM and control register must be accessed in less than 1/4 frequency shown below.
(Example: After one access, non-access cycles more than three cycles are necessary to be inserted.)

[Example 1]



[Example 2]



As shown in the above [example 2], when HD146818 is accessed continuously, continuous access must not be executed over fifty times.

- (iii) The application that User RAM is used for program area should be avoided. (Inhibit continuous access.)
- (iv) Minimize the noise by inserting noise bypass condenser between power supply and ground pin ($V_{CC}-V_{SS}$).
(Insert noise bypass condenser as near HD146818 as possible.)

HD6318, HD63A18

RTC (Real Time Clock Plus RAM)

—ADVANCE INFORMATION—

The HD6318 is a HMCS6800 peripheral CMOS device which combines three unique features: a complete time-of-day clock with alarm and one hundred calendar, a programmable periodic interrupt and square-wave generator, and 50 bytes of Low-power static RAM.

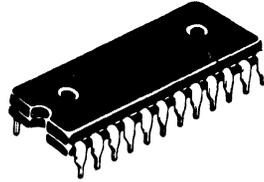
This device includes HD6801, HD6301 multiplexed bus interface circuit and 8085's multiplexed bus interface as well, so it can be directly connected to HD6801, HD6301 and 8085.

The Real-Time Clock plus RAM has two distinct uses. First, it is designed as battery powered CMOS part including all the common battery backed-up functions such as RAM, time, and calendar. Secondly, the HD6318 may be used with a CMOS microprocessor to relieve the software of timekeeping workload and to extend the available RAM of an MPU such as the HD6301.

■ FEATURES

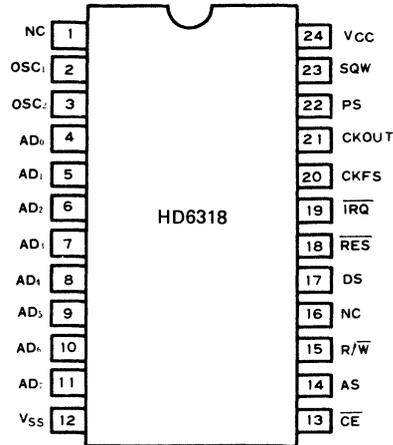
- Revised product of HD146818 in both Function and Characteristics
- Compatible with HD146818 and Motorola MC146818
- Time-of-Day Clock and Calendar
 - Counts Seconds, Minutes, and Hours of the Day
 - Counts Days of Week, Date, Month, and Year
- Binary or BCD Representation of Time, Calendar, and Alarm
- 12- or 24 Hour Clock with AM and PM in 12-Hour Mode
- Automatic End of Month Recognition
- Automatic Leap Year Compensation
- Interfaced with Software as 64 RAM Locations
 - 14 Bytes of Clock and Control Register
 - 50 Bytes of General Purpose RAM
- Three Interrupt are Separately Software Maskable and Testable
 - Time-of-Day Alarm, Once-per-Second to Once-per-Day
 - Periodic Rates from 30.5 μ s to 500 ms
 - End-of-Clock Update Cycle
- Programmable Square-Wave Output Signal
- Three Time Base Input Options
 - 4.194304 MHz
 - 1.048576 MHz
 - 32.768 kHz
- Clock Output May be used as Microprocessor Clock Input
 - At Time Base Frequency \div 4 or \div 1
- Multiplexed Bus Interface Circuit of HD6801, HD6301 and 8085
- Low-Power, High-Speed, High-Density CMOS
- Battery Backed-up Operation

HD6318P, HD63A18P



(DP-24)

■ PIN ARRANGEMENT

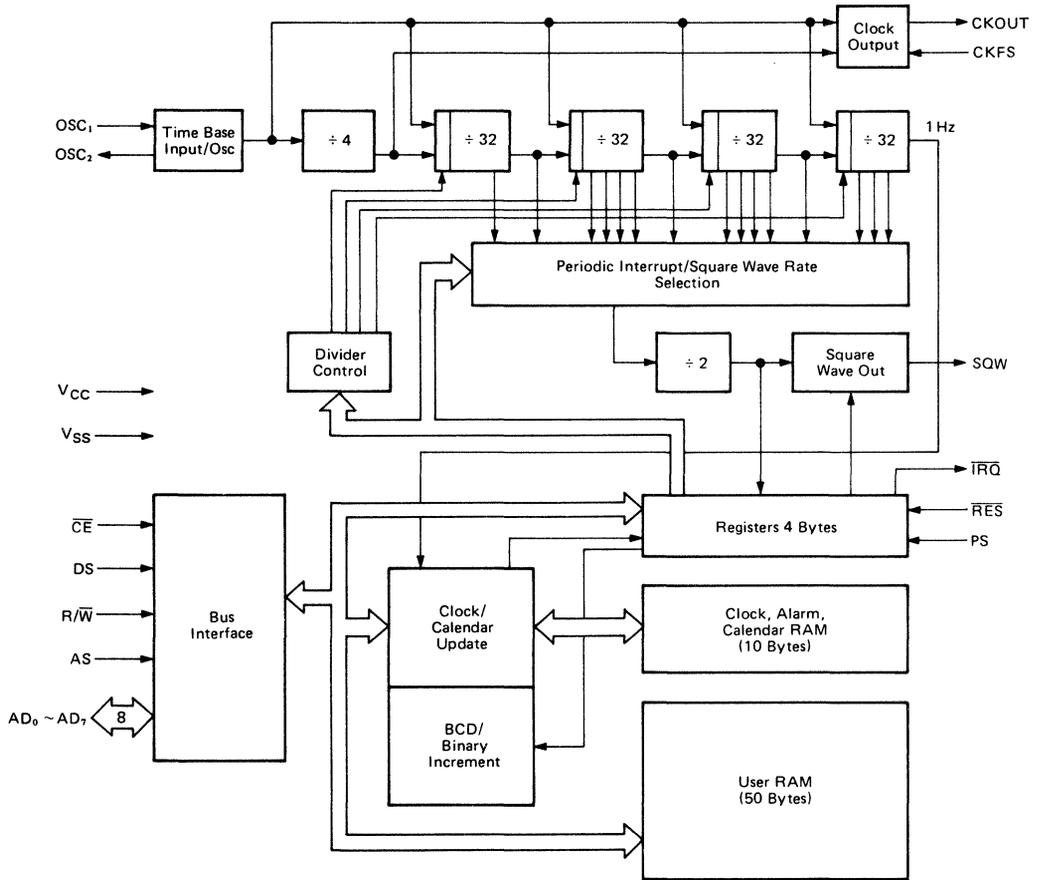


(Top View)

■ TYPE OF PRODUCTS

Type No.	Bus Timing
HD6318	1.0 MHz
HD63A18	1.5 MHz

■ BLOCK DIAGRAM



**16-BIT MULTI-CHIP
MICROCOMPUTERS**

HD68000, HD68000Y HD68000Z MPU (Micro Processing Unit)

Advances in semiconductor technology have provided the capability to place on a single silicon chip a microprocessor at least an order of magnitude higher in performance and circuit complexity than has been previously available. The HD68000 is one of such VLSI microprocessors. It combines state-of-the-art technology and advanced circuit design techniques with computer sciences to achieve an architecturally advanced 16-bit microprocessor.

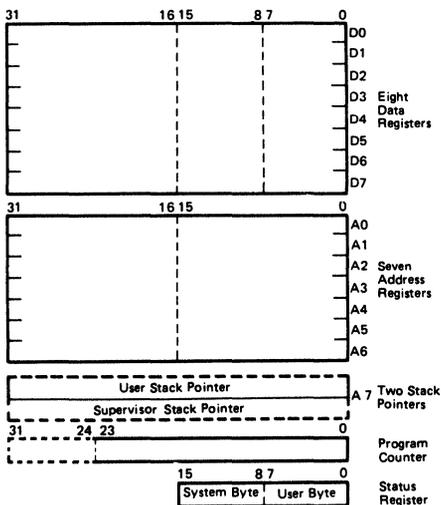
The resources available to the HD68000 user consist of the following.

As shown in the programming model, the HD68000 offers seventeen 32-bit registers in addition to the 32-bit program counter and a 16-bit status register. The first eight registers (D0-D7) are used as data registers for byte (8-bit), word (16-bit), and long word (32-bit) data operations. The second set of seven registers (A0-A6) and the system stack pointer may be used as software stack pointers and base address registers. In addition, these registers may be used for word and long word address operations. All 17 registers may be used as index registers.

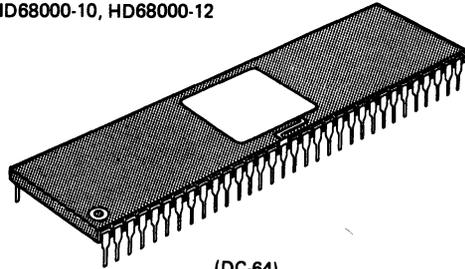
FEATURES

- 32-Bit Data and Address Registers
- 16 Megabyte Direct Addressing Range
- 56 Powerful Instruction Types
- Operations of Five Main Data Types
- Memory Mapped I/O
- 14 Addressing Modes
- Compatible with MC68000L4/L6/L8/L10/L12, MC68000R4/R6/R8/R10/R12 and MC68000Z4/Z6/Z8/Z10/Z12

PROGRAMMING MODEL

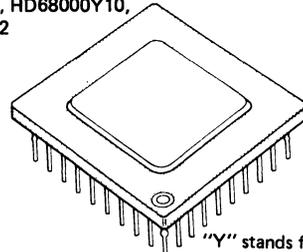


HD68000-4, HD68000-6, HD68000-8,
HD68000-10, HD68000-12



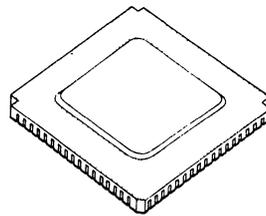
(DC-64)

HD68000Y4, HD68000Y6,
HD68000Y8, HD68000Y10,
HD68000Y12



(PGA-68) "Y" stands for Pin Grid Array Package.

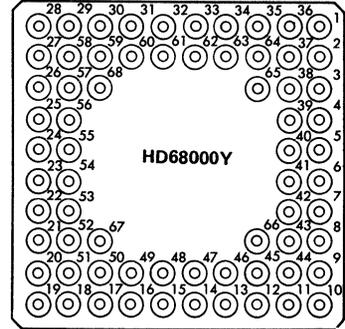
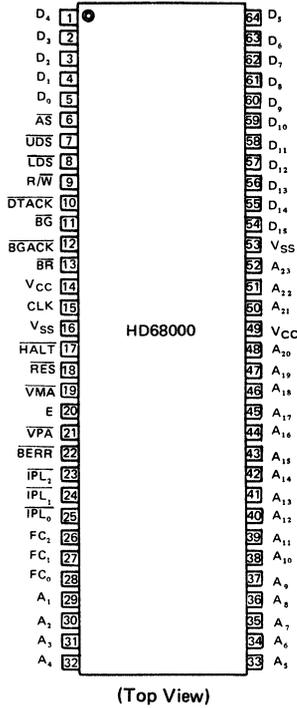
HD68000Z4, HD68000Z6,
HD68000Z8, HD68000Z10,
HD68000Z12



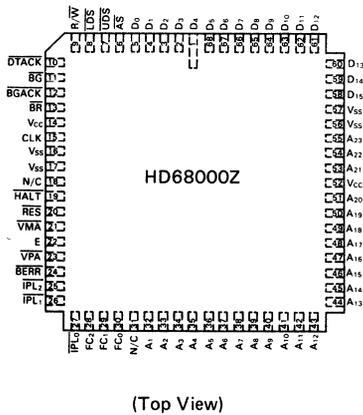
(CG-68) "Z" stands for Leadless Chip Carrier Package.

As for package used for HD68000Z, Leadless Chip Carrier Package is preliminary.

■ PIN ARRANGEMENT



Pin No.	Function	Pin No.	Function	Pin No.	Function	Pin No.	Function
1	N/C	18	A ₉	35	D ₁	52	A ₁₂
2	DTACK	19	N/C	36	AS	53	A ₁₅
3	BGACK	20	A ₁₄	37	LDS	54	A ₁₈
4	BR	21	A ₁₆	38	BG	55	V _{CC}
5	CLK	22	A ₁₇	39	V _{CC}	56	V _{SS}
6	HALT	23	A ₁₈	40	V _{SS}	57	A ₂₃
7	VMA	24	A ₂₀	41	RES	58	D ₁₄
8	E	25	A ₂₁	42	VPA	59	D ₁₁
9	BERR	26	A ₂₂	43	IPL ₁	60	D ₉
10	N/C	27	D ₁₅	44	IPL ₀	61	D ₆
11	FC ₂	28	D ₁₂	45	FC ₁	62	D ₃
12	FC ₀	29	D ₁₀	46	N/C	63	D ₀
13	A ₁	30	D ₈	47	A ₂	64	UDS
14	A ₃	31	D ₇	48	A ₃	65	R/W
15	A ₄	32	D ₅	49	A ₈	66	IPL ₁
16	A ₆	33	D ₄	50	A ₁₀	67	A ₁₃
17	A ₇	34	D ₂	51	A ₁₁	68	D ₁₃



■ TYPE OF PRODUCTS

Type No.	Package	Clock Frequency (MHz)
HD68000-4	DC-64	4.0
HD68000-6		6.0
HD68000-8		8.0
HD68000-10		10.0
HD68000-12	PGA-68	12.5
HD68000Y4		4.0
HD68000Y6		6.0
HD68000Y8		8.0
HD68000Y10	CG-68	10.0
HD68000Y12		12.5
HD68000Z4		4.0
HD68000Z6		6.0
HD68000Z8	CG-68	8.0
HD68000Z10		10.0
HD68000Z12		12.5

■ ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Value	Unit
Supply Voltage	V _{CC} *	-0.3 ~ +7.0	V
Input Voltage	V _{in} *	-0.3 ~ +7.0	V
Operating Temperature Range	T _{opr}	0 ~ +70	°C
Storage Temperature	T _{stg}	-55 ~ +150	°C

* With respect to V_{SS} (SYSTEM GND)

(NOTE) Permanent LSI damage may occur if maximum ratings are exceeded. Normal operation should be under recommended operating conditions. If these conditions are exceeded, it could affect reliability of LSI.

■ RECOMMENDED OPERATING CONDITIONS

Item	Symbol	min	typ	max	Unit
Supply Voltage	V _{CC} *	4.75	5.0	5.25	V
Input Voltage	V _{IH} *	2.0	—	V _{CC}	V
	V _{IL} *	-0.3	—	0.8	V
Operating Temperature	T _{opr}	0	25	70	°C

* With respect to V_{SS} (SYSTEM GND)

■ ELECTRICAL CHARACTERISTICS

● DC CHARACTERISTICS (V_{CC} = 5V ±5%, V_{SS} = 0V, T_a = 0 ~ +70°C, Fig. 1, 2, 3, unless otherwise noted.)

Item	Symbol	Test Condition	min	max	Unit		
Input "High" Voltage	V _{IH}		2.0	V _{CC}	V		
Input "Low" Voltage	V _{IL}		V _{SS} -0.3	0.8	V		
Input Leakage Current	I _{in}	@ 5.25V	—	2.5	μA		
			—	20			
Three-State (Off State) Input Current	I _{TSI}	@ 2.4V/0.4V	—	20	μA		
Output "High" Voltage	V _{OH}	I _{OH} = -400 μA	2.4	—	V		
			V _{CC} -0.75	—			
Output "Low" Voltage	V _{OL}	I _{OL} = 1.6 mA	—	0.5	V		
			I _{OL} = 3.2 mA	—		0.5	
				I _{OL} = 5.3 mA		—	0.5
						I _{OL} = 5.3 mA	—
Power Dissipation	P _D			—	1.5**	W	
Capacitance (Package Type Dependent)	C _{in}	V _{in} = 0V, T _a = 25°C, f = 1 MHz	—	20.0	pF		

* With external pull up resistor of 1.1 kΩ.
** 1.75W at f = 12.5 MHz

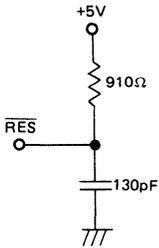


Figure 1 RES Test Load

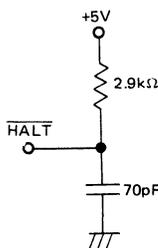
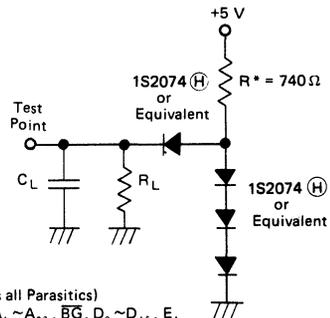


Figure 2 HALT Test Load



C_L = 130 pF (Includes all Parasitics)
R_L = 6.0 kΩ for AS, A₁ ~ A₂₃, BG, D₀ ~ D₁₅, E,
FC₀ ~ FC₂, LDS, R/W, UDS, VMA
*R = 1.22 kΩ for A₁ ~ A₂₃, BG, FC₀ ~ FC₂

Figure 3 Test Loads

• AC CHARACTERISTICS (V_{CC} = 5.0V ±5%, V_{SS} = 0V, T_a = 0 ~ +70°C, unless otherwise noted.)

Number	Item	Symbol	Test Condition	4MHz Version		6MHz Version		8MHz Version		10MHz Version		12.5MHz Version		Unit		
				HD68000-4	HD68000-4	HD68000-6	HD68000-6	HD68000-8	HD68000-8	HD68000-10	HD68000-10	HD68000-12	HD68000-12			
				HD68000Y4	HD68000Z4	HD68000Y6	HD68000Z6	HD68000Y8	HD68000Z8	HD68000Y10	HD68000Z10	HD68000Y12	HD68000Z12			
				min	max	min	max	min	max	min	max	min	max			
	Frequency of Operation	f		2.0	4.0	2.0	6.0	2.0	8.0	2.0	10.0	4.0	12.5	MHz		
①	Clock Period	t _{cyc}		250	500	167	500	125	500	100	500	80	250	ns		
②	Clock Width "Low"	t _{CL}		115	250	75	250	55	250	45	250	35	125	ns		
③	Clock Width "High"	t _{CH}		115	250	75	250	55	250	45	250	35	125	ns		
④	Clock Fall Time	t _{Cf}		--	10	--	10	--	10	--	10	--	5	ns		
⑤	Clock Rise Time	t _{Cr}		--	10	--	10	--	10	--	10	--	5	ns		
⑥	Clock "Low" to Address	t _{CLAV}		--	90	--	80	--	70	--	60	--	55	ns		
⑥A	Clock "High" to FC Valid	t _{CHFCV}		--	90	--	80	--	80	--	60	--	55	ns		
⑦	Clock "High" to Address/Data High Impedance (Maximum)	t _{CHAZx}		--	120	--	100	--	80	--	70	--	60	ns		
⑧	Clock "High" to Address/FC Invalid (Minimum)	t _{CHAZn}		0	--	0	--	0	--	0	--	0	--	ns		
⑨ ¹	Clock "High" to \overline{AS} , \overline{DS} "Low" (Maximum)	t _{CHSLx}		--	80	--	70	--	60	--	55	--	55	ns		
⑩	Clock "High" to \overline{AS} , \overline{DS} "Low" (Minimum)	t _{CHSLn}		0	--	0	--	0	--	0	--	0	--	ns		
⑪ ²	Address to \overline{AS} , \overline{DS} (Read) "Low" \overline{AS} Write	t _{AVSL}		55	--	35	--	30	--	20	--	0	--	ns		
⑪A ²	FC Valid to \overline{AS} , \overline{DS} (Read) "Low" \overline{AS} Write	t _{FCVSL}		80	--	70	--	60	--	50	--	40	--	ns		
⑫ ¹	Clock "Low" to \overline{AS} , \overline{DS} "High"	t _{CLSH}		--	90	--	80	--	70	--	55	--	50	ns		
⑬ ²	\overline{AS} , \overline{DS} "High" to Address/FC Invalid	t _{SHAZ}		60	--	40	--	30	--	20	--	10	--	ns		
⑭ ²	\overline{AS} , \overline{DS} Width "Low" (Read)/ \overline{AS} Write	t _{SL}		535	--	337	--	240	--	195	--	160	--	ns		
⑭A ²	\overline{DS} Width "Low" (Write)	--		285	--	170	--	115	--	95	--	80	--	ns		
⑮ ²	\overline{AS} , \overline{DS} Width "High"	t _{SH}		285	--	180	--	150	--	105	--	65	--	ns		
⑯	Clock "High" to \overline{AS} , \overline{DS} High Impedance	t _{CHSZ}		--	120	--	100	--	80	--	70	--	60	ns		
⑰ ²	\overline{AS} , \overline{DS} "High" to R/ \overline{W} "High"	t _{SHRH}		60	--	50	--	40	--	20	--	10	--	ns		
⑱ ¹	Clock "High" to R/ \overline{W} "High" (Maximum)	t _{CHRHx}		--	90	--	80	--	70	--	60	--	60	ns		
⑲	Clock "High" to R/ \overline{W} "High" (Minimum)	t _{CHRHn}		0	--	0	--	0	--	0	--	0	--	ns		
⑳ ¹	Clock "High" to R/ \overline{W} "Low"	t _{CHRL}		--	90	--	80	--	70	--	60	--	60	ns		
⑳A	\overline{AS} "Low" to R/ \overline{W} Valid	t _{ASRV}	Fig. 4 ~Fig. 7	--	20	--	20	--	20	--	20	--	20	ns		
㉑ ²	Address Valid to R/ \overline{W} "Low"	t _{AVRL}		45	--	25	--	20	--	0	--	0	--	ns		
㉑A ²	FC Valid to R/ \overline{W} "Low"	t _{FCVRL}		80	--	70	--	60	--	50	--	30	--	ns		
㉒ ²	R/ \overline{W} "Low" to \overline{DS} "Low" (Write)	t _{RLSL}		200	--	140	--	80	--	50	--	30	--	ns		
㉓	Clock "Low" to Data Out Valid	t _{CLDO}		--	90	--	80	--	70	--	55	--	55	ns		
㉔ ²	\overline{DS} "High" to Data Out Invalid	t _{SHDO}		60	--	40	--	30	--	20	--	15	--	ns		
㉕ ²	Data Out Valid to \overline{DS} "Low" (Write)	t _{DOSL}		55	--	35	--	30	--	20	--	15	--	ns		
㉖ ⁵	Data In to Clock "Low" (Setup Time)	t _{DICL}		30	--	25	--	15	--	10	--	10	--	ns		
㉗ ²	\overline{AS} , \overline{DS} "High" to \overline{DTACK} "High"	t _{SHDAH}		0	490	0	325	0	245	0	190	0	150	ns		
㉘	\overline{DS} "High" to Data Invalid (Hold Time)	t _{SHDI}		0	--	0	--	0	--	0	--	0	--	ns		
㉙	\overline{AS} , \overline{DS} "High" to \overline{BERR} "High"	t _{SHBEH}		0	--	0	--	0	--	0	--	0	--	ns		
㉙ ^{2,5}	\overline{DTACK} "Low" to Data In (Setup Time)	t _{DALDI}		--	180	--	120	--	90	--	65	--	50	ns		
㉚	HALT and RES Input Transition Time	t _{RHrf}		0	200	0	200	0	200	0	200	0	200	ns		
㉛	Clock "High" to \overline{BG} "Low"	t _{CHGL}		--	90	--	80	--	70	--	60	--	50	ns		
㉜	Clock "High" to \overline{BG} "High"	t _{CHGH}		--	90	--	80	--	70	--	60	--	50	ns		
㉝	\overline{BR} "Low" to \overline{BG} "Low"	t _{BRLGL}		1.5	3.5	1.5	3.5	1.5	3.5	1.5	3.5	1.5	3.5	Cik.Per.		
㉞	\overline{BR} "High" to \overline{BG} "High"	t _{BRHGH}		1.5	3.5	1.5	3.5	1.5	3.5	1.5	3.5	1.5	3.5	Cik.Per.		
㉟	\overline{BGACK} "Low" to \overline{BG} "High"	t _{GALGH}		1.5	3.0	1.5	3.0	1.5	3.0	1.5	3.0	1.5	3.0	Cik.Per.		
㊱	\overline{BG} "Low" to Bus High Impedance (With \overline{AS} "High")	t _{GLZ}		--	120	--	100	--	80	--	70	--	60	ns		
㊲	\overline{BG} Width "High"	t _{GH}		1.5	--	1.5	--	1.5	--	1.5	--	1.5	--	Cik.Per.		
㊳	\overline{BGACK} Width "Low"	t _{BGL}		1.5	--	1.5	--	1.5	--	1.5	--	1.5	--	Cik.Per.		
㊴ ⁵	Asynchronous Input Setup Time	t _{ASI}		30	--	25	--	20	--	20	--	20	--	ns		
㊵	\overline{BERR} "Low" to \overline{DTACK} "Low" (Note 3)	t _{BELDAL}		30	--	25	--	20	--	20	--	20	--	ns		
㊶	Data Hold from Clock "High"	t _{CHDO}		0	--	0	--	0	--	0	--	0	--	ns		
㊷	R/ \overline{W} to Data Bus Impedance Change	t _{RLDO}		55	--	35	--	30	--	20	--	10	--	ns		
㊸	HALT /RES Pulse Width (Note 4)	t _{HRPW}		10	--	10	--	10	--	10	--	10	--	Cik.Per.		

(to be continued)

Number	Item	Symbol	Test Condition	4MHz Version		6MHz Version		8MHz Version		10MHz Version		12.5MHz Version		Unit
				HD68000-4 HD68000Y4 HD68000Z4		HD68000-6 HD68000Y6 HD68000Z6		HD68000-8 HD68000Y8 HD68000Z8		HD68000-10 HD68000Y10 HD68000Z10		HD68000-12 HD68000Y12 HD68000Z12		
				min	max	min	max	min	max	min	max	min	max	
②④	Clock "High" to R \bar{W} , \bar{VMA} High Impedance	tCHRZ	Fig. 45, Fig. 46	-	120	100	-	80	-	70	-	60	ns	
④⑥	Clock "Low" to \bar{VMA} "Low"	tCLVML		-	90	80	-	70	-	70	-	70	ns	
④①	Clock "Low" to E Transition	tCLE		-	100	85	-	70	-	55	-	45	ns	
④②	E Output Rise and Fall Time	tErf		-	25	25	-	25	-	25	-	25	ns	
④③	\bar{VMA} "Low" to E "High"	tVMLEH		325	-	240	-	200	-	150	-	90	-	ns
④④	\bar{AS} , \bar{DS} "High" to \bar{VPA} "High"	tSHVPH		0	240	0	160	0	120	0	90	0	70	ns
④⑤	E "Low" to Address \bar{VMA} FC Invalid	tELAI		55	-	35	-	30	-	10	-	10	-	ns
④⑨	E "Low" to \bar{AS} , \bar{DS} Invalid	tELSI		-80	-	-80	-	-80	-	-80	-	-80	-	ns
⑤⑥	E Width "High"	tEH		900	-	600	-	450	-	350	-	280	-	ns
⑤①	E Width "Low"	tEL		1400	-	900	-	700	-	550	-	440	-	ns
⑤②	E Extended Rise Time	tCIEHX		-	80	-	80	-	80	-	80	-	80	ns
⑤④	Data Hold from E "Low" (Write)	tELDOZ		60	-	40	-	30	-	20	-	15	-	ns

- (NOTES) 1. For a loading capacitance of less than or equal to 50 picofarads, subtract 5 nanoseconds from the values given in these columns.
 2. Actual value depends on clock period.
 3. If #47 is satisfied for both \bar{DTACK} and \bar{BERR} , #48 may be 0 ns.
 4. After V_{CC} has been applied for 100 ms.
 5. If the asynchronous setup time (#47) requirements are satisfied, the \bar{DTACK} low-to-data setup time (#31) requirement can be ignored. The data must only satisfy the data-in to clock-low setup time (#27) for the following cycle.

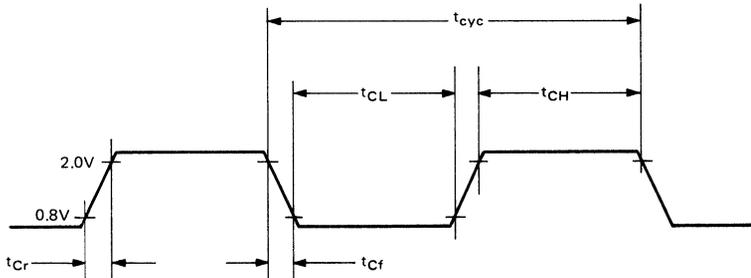
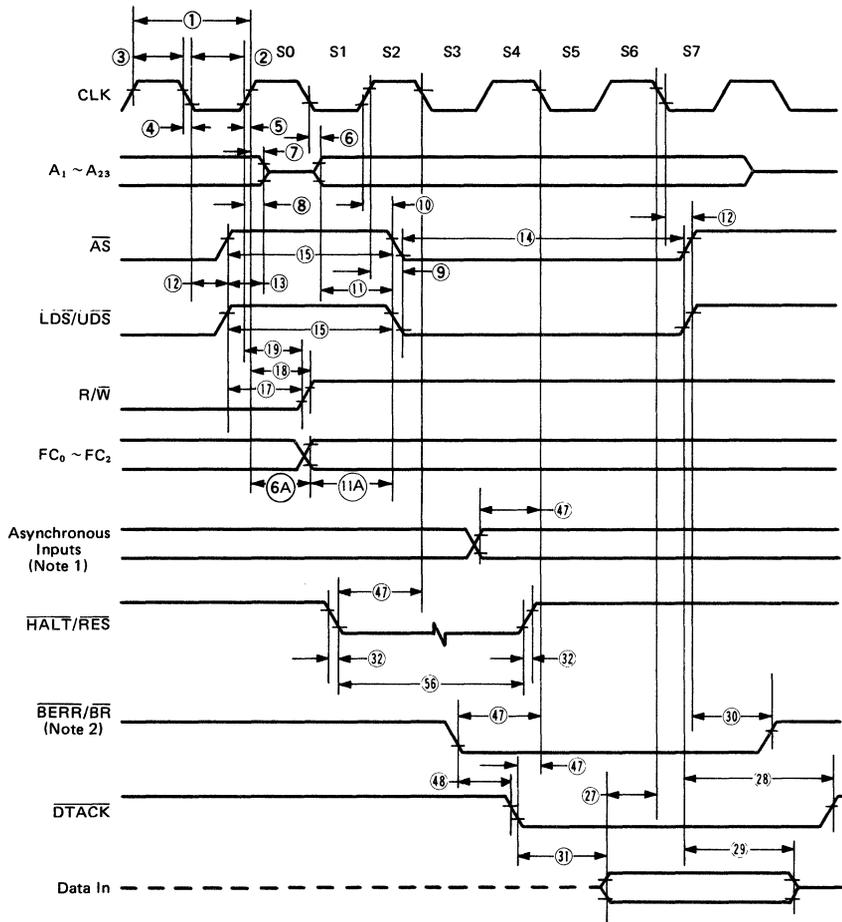
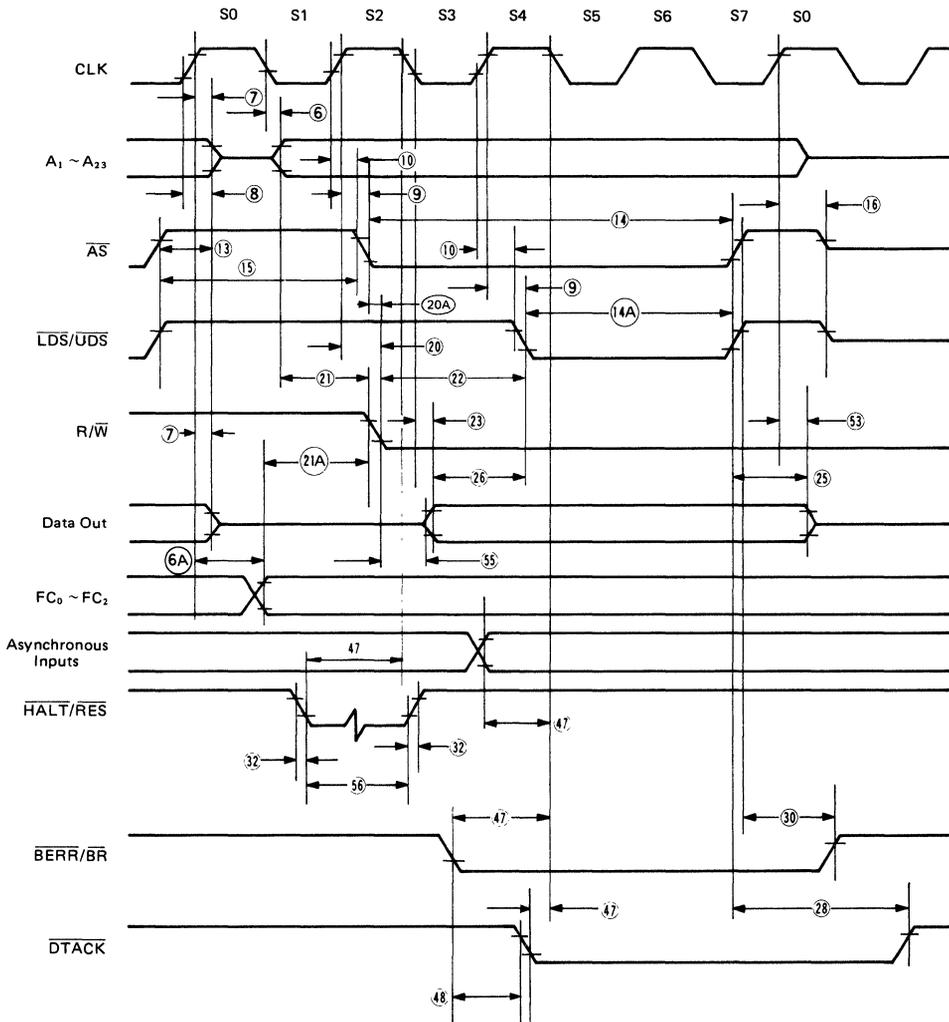


Figure 4 Input Clock Waveform



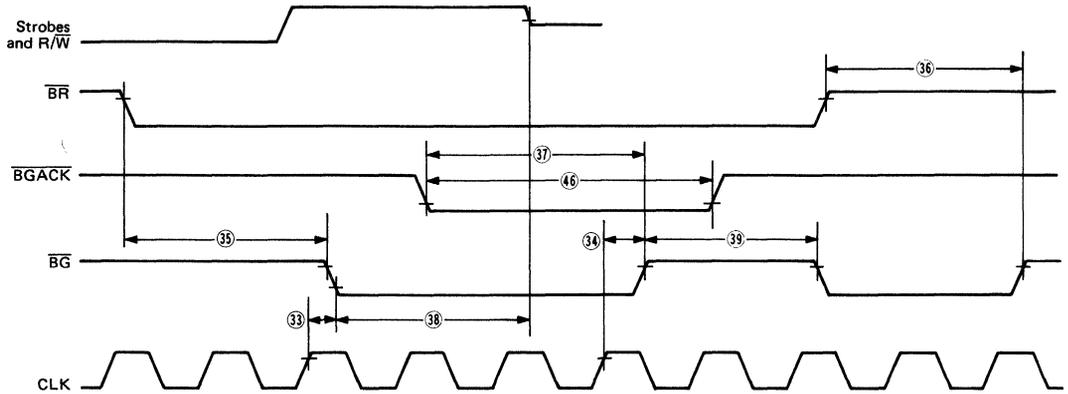
- (NOTES) 1. Setup time for the asynchronous inputs \overline{BGACK} , $\overline{IPL}_0 \sim \overline{IPL}_2$ and \overline{VPA} guarantees their recognition at the next falling edge of the clock.
 2. \overline{BR} need fall at this time only in order to insure being recognized at the end of this bus cycle.
 3. Timing measurements are referenced to and from a low voltage of 0.8 volts and a high voltage of 2.0 volts, unless otherwise noted.
 4. These waveforms should only be referenced in regard to the edge-to-edge measurement of the timing specifications. They are not intended as a functional description of the input and output signals. Refer to other functional descriptions and their related diagrams for device operation.

Figure 5 Read Cycle Timing



- (NOTES) 1. Timing measurements are referenced to and from a low voltage of 0.8 volts and a high voltage of 2.0 volts, unless otherwise noted.
 2. Because of loading variations, R/ \overline{W} may be valid after \overline{AS} even though both are initiated by the rising edge of S2 (Specification (20A)).
 3. These waveforms should only be referenced in regard to the edge-to-edge measurement of the timing specifications. They are not intended as a functional description of the input and output signals. Refer to other functional descriptions and their related diagrams for device operation.

Figure 6 Write Cycle Timing



- (NOTES) 1. Setup time for the asynchronous inputs \overline{BERR} , \overline{BGACK} , \overline{BR} , \overline{DTACK} , $\overline{IPL}_0 \sim \overline{IPL}_2$, and \overline{VPA} guarantees their recognition at the next falling edge of the clock.
 2. Waveform measurements for all inputs and outputs are specified at: logic high = 2.0 volts, logic low = 0.8 volts.
 3. These waveforms should only be referenced in regard to the edge-to-edge measurement of the timing specifications. They are not intended as a functional description of the input and output signals. Refer to other functional descriptions and their related diagrams for device operation.

Figure 7 AC Electrical Waveforms – Bus Arbitration

■ SIGNAL DESCRIPTION

The following paragraphs contain a brief description of the input and output signals. A discussion of bus operation during the various machine cycles and operations is also given.

● SIGNAL DESCRIPTION

The input and output signals can be functionally organized into the groups shown in Figure 8. The following paragraphs provide a brief description of the signals and also a reference (if applicable) to other paragraphs that contain more detail about the function being performed.

ADDRESS BUS (A_1 through A_{23})

This 23-bit, unidirectional, three-state bus is capable of addressing 8 megawords of data. It provides the address for bus operation during all cycles except interrupt cycles. During interrupt cycles, address lines A_1 , A_2 , and A_3 Provide information about what level interrupt is being serviced while address lines A_4 through A_{23} are all set to a logic high.

DATA BUS (D_0 through D_{15})

This 16-bit, bidirectional, three-state bus is the general purpose data path. It can transfer and accept data in either word or byte length. During an interrupt acknowledge cycle, an external device supplies the vector number on data lines $D_0 \sim D_7$.

ASYNCHRONOUS BUS CONTROL

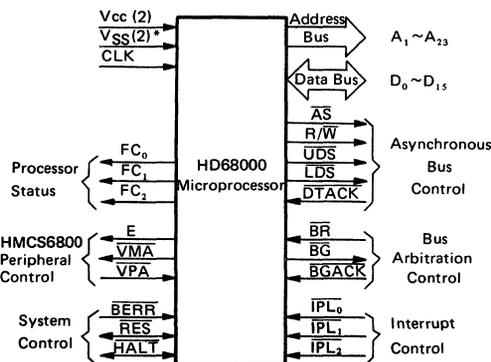
Asynchronous data transfer are handled using the following control signals: address strobe, read/write, upper and lower data strobes, and data transfer acknowledge. These signals are explained in the following paragraphs.

Address Strobe (\overline{AS})

This signal indicates that there is a valid address on the address bus.

Read/Write (R/\overline{W})

This signal defines the data bus transfer as a read or write cycle. The R/\overline{W} signal also works in conjunction with the upper and lower data strobes as explained in the following paragraph.



* HD68000Z has 4 lines.

Figure 8 Input and Output Signals

Upper and Lower Data Strobes (\overline{UDS} , \overline{LDS})

These signals control the data on the data bus, as shown in Table 1. When the R/W line is high, the processor will read from the data bus as indicated. When the R/W line is low, the processor will write to the data bus as shown.

Table 1 Data Strobe Control of Data Bus

\overline{UDS}	\overline{LDS}	R/W	$D_8 \sim D_{15}$	$D_0 \sim D_7$
High	High	—	No valid data	No valid data
Low	Low	High	Valid data bits 8 ~ 15	Valid data bits 0 ~ 7
High	Low	High	No valid data	Valid data bits 0 ~ 7
Low	High	High	Valid data bits 8 ~ 15	No valid data
Low	Low	Low	Valid data bits 8 ~ 15	Valid data bits 0 ~ 7
High	Low	Low	Valid data bits 0 ~ 7*	Valid data bits 0 ~ 7
Low	High	Low	Valid data bits 8 ~ 15	Valid data bits 8 ~ 15*

* These conditions are a result of current implementation and may not appear on future devices.

Data Transfer Acknowledge (\overline{DTACK})

This input indicates that the data transfer is completed. When the processor recognizes \overline{DTACK} during a read cycle, data is latched and the bus cycle terminated. When \overline{DTACK} is recognized during a write cycle, the bus cycle is terminated.

An active transition of data transfer acknowledge, \overline{DTACK} , indicates the termination of a data transfer on the bus.

If the system must run at a maximum rate determined by RAM access times, the relationship between the times at which \overline{DTACK} and DATA are sampled are important.

All control and data lines are sampled during the HD68000's clock high time. The clock is internally buffered, which results in some slight differences in the sampling and recognition of various signals. HD68000 allow BERR or \overline{DTACK} to be recognized in S4, S6, etc., which terminates the cycle*. The \overline{DTACK} signal, like other control signals, is internally synchronized to allow for valid operation in an asynchronous system. If the required setup time (#47) is met during S4, \overline{DTACK} will be recognized during S5 and S6, and data will be captured during S6. The data must meet the required setup time (#27).

If an asynchronous control signal does not meet the required setup time, it is possible that it may not be recognized during that cycle. Because of this, asynchronous systems must not allow \overline{DTACK} to precede data by more than parameter #31.

Asserting \overline{DTACK} (or BERR) on the rising edge of a clock (such as S4) after the assertion of address strobe will allow a HD68000 system to run at its maximum bus rate. If setup times #27 and #47 are guaranteed, #31 may be ignored.

* The mask version 68000 allowed \overline{DTACK} to be recognized as early as S2 (bus state 2).

BUS ARBITRATION CONTROL

These three signals form a bus arbitration circuit to determine which device will be the bus master device.

Bus Request (\overline{BR})

This input is wire ORed with all other devices that could be bus masters. This input indicates to the processor that some other device desires to become the bus master.

Bus Grant (\overline{BG})

This output indicates to all other potential bus master devices that the processor will release bus control at the end of the current bus cycle.

Bus Grant Acknowledge (\overline{BGACK})

This input indicates that some other device has become the bus master. This signal cannot be asserted until the following four conditions are met:

- (1) A Bus Grant has been received
- (2) Address Strobe is inactive which indicates that the microprocessor is not using the bus
- (3) Data Transfer Acknowledge is inactive which indicates that neither memory nor peripherals are using the bus
- (4) Bus Grant Acknowledge is inactive which indicates that no other device is still claiming bus mastership.

INTERRUPT CONTROL (\overline{IPL}_0 , \overline{IPL}_1 , \overline{IPL}_2)

These input pins indicate the encoded priority level of the device requesting an interrupt. Level seven is the highest priority while level zero indicates that no interrupts are requested. The least significant bit is given in \overline{IPL}_0 and the most significant bit is contained in \overline{IPL}_2 .

SYSTEM CONTROL

The system control inputs are used to either reset or halt the processor and to indicate to the processor that bus errors have occurred. The three system control inputs are explained in the following paragraphs.

Bus Error (\overline{BERR})

This input informs the processor that there is a problem with the cycle currently being executed. Problems may be a result of:

- (1) Nonresponding devices
- (2) Interrupt vector number acquisition failure
- (3) Illegal access request as determined by a memory management unit
- (4) Other application dependent errors.

The bus error signal interacts with the halt signal to determine if exception processing should be performed or the current bus cycle should be retried.

Refer to **BUS ERROR AND HALT OPERATION** paragraph for additional information about the interaction of the bus error and halt signals.

Reset (\overline{RES})

This bidirectional signal line acts to reset (initiate a system initialization sequence) the processor in response to an external reset signal. An internally generated reset (result of a RESET instruction) causes all external devices to be reset and the internal state of the processor is not affected. A total system reset (processor and external devices) is the result of external HALT and RESET signals applied at the same time. Refer to **RESET OPERATION** paragraph for additional information about reset operation.

Halt (\overline{HALT})

When this bidirectional line is driven by an external device,

it will cause the processor to stop at the completion of the current bus cycle. When the processor has been halted using this input, all control signals are inactive and all three-state lines are put in their high-impedance state. Refer to **BUS ERROR AND HALT OPERATION** paragraph for additional information about the interaction between the halt and bus error signals.

When the processor has stopped executing instructions, such as in a double bus fault condition, the halt line is driven by the processor to indicate to external devices that the processor has stopped.

HMCS6800 PERIPHERAL CONTROL

These control signals are used to allow the interfacing of synchronous HMCS6800 peripheral devices with the asynchronous HD68000. These signals are explained in the following paragraphs.

Enable (E)

This signal is the standard enable signal common to all HMCS6800 type peripheral devices. The period for this output is ten HD68000 clock periods (six clocks low; four clocks high).

Valid Peripheral Address (VPA)

This input indicates that the device or region addressed is a HMCS6800 family device and that data transfer should be synchronized with the enable (E) signal. This input also indicates that the processor should use automatic vectoring for an interrupt. Refer to **INTERFACE WITH HMCS6800 PERIPHERALS**.

Valid Memory Address (VMA)

This output is used to indicate to HMCS6800 peripheral

devices that there is a valid address on the address bus and the processor is synchronized to enable. This signal only responds to a valid peripheral address (VPA) input which indicates that the peripheral is a HMCS6800 family device.

PROCESSOR STATUS (FC₀, FC₁, FC₂)

These function code outputs indicate the state (user or supervisor) and the cycle type currently being executed, as shown in Table 2. The information indicated by the function code outputs is valid whenever address strobe (AS) is active.

Table 2 Function Code Outputs

FC ₂	FC ₁	FC ₀	Cycle Type
Low	Low	Low	(Undefined, Reserved)
Low	Low	High	User Data
Low	High	Low	User Program
Low	High	High	(Undefined, Reserved)
High	Low	Low	(Undefined, Reserved)
High	Low	High	Supervisor Data
High	High	Low	Supervisor Program
High	High	High	Interrupt Acknowledge

CLOCK (CLK)

The clock input is a TTL-compatible signal that is internally buffered for development of the internal clocks needed by the processor. The clock input shall be a constant frequency.

SIGNAL SUMMARY

Table 3 is a summary of all the signals discussed in the previous paragraphs.

Table 3 Signal Summary

Signal Name	Mnemonic	Input/Output	Active State	Three State	
				On BGACK	On HALT
Address Bus	A ₁ ~ A ₂₃	output	high	yes	yes
Data Bus	D ₀ ~ D ₁₅	input/output	high	yes	yes
Address Strobe	AS	output	low	yes	no
Read/Write	R/W	output	read-high write-low	yes	no
Upper and Lower Data Strobes	UDS, LDS	output	low	yes	no
Data Transfer Acknowledge	DTACK	input	low	no	no
Bus Request	BR	input	low	no	no
Bus Grant	BG	output	low	no	no
Bus Grant Acknowledge	BGACK	input	low	no	no
Interrupt Priority Level	IPL ₀ , IPL ₁ , IPL ₂	input	low	no	no
Bus Error	BERR	input	low	no	no
Reset	RES	input/output	low	no*	no*
Halt	HALT	input/output	low	no*	no*
Enable	E	output	high	no	no
Valid Memory Address	VMA	output	low	yes	no
Valid Peripheral Address	VPA	input	low	no	no
Function Code Output	FC ₀ , FC ₁ , FC ₂	output	high	yes	no
Clock	CLK	input	high	no	no
Power Input	V _{CC}	input	—	—	—
Ground	V _{SS}	input	—	—	—

* Open drain

■ REGISTER DESCRIPTION AND DATA ORGANIZATION

The following paragraphs describe the registers and data organization of the HD68000.

● OPERAND SIZE

Operand sizes are defined as follows: a byte equals 8 bits, a word equals 16 bits, and a long word equals 32 bits. The operand size for each instruction is either explicitly encoded in the instruction or implicitly defined by the instruction operation. All explicit instructions support byte, word or long word operands. Implicit instructions support some subset of all three sizes.

● DATA ORGANIZATION IN REGISTERS

The eight data registers support data operands of 1, 8, 16, or 32 bits. The seven address registers together with the active stack pointer support address operands of 32 bits.

DATA REGISTERS

Each data register is 32 bits wide. Byte operands occupy the low order 8 bits, word operands the low order 16 bits, and long word operands the entire 32 bits. The least significant bit is addressed as bit zero; the most significant bit is addressed as bit 31.

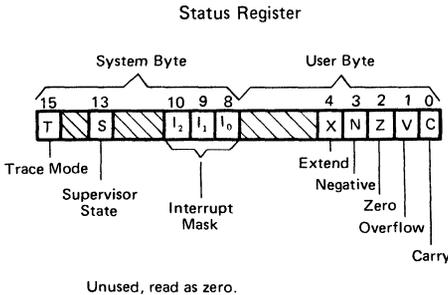
When a data register is used as either a source or destination operand, only the appropriate low-order portion is changed; the remaining high-order portion is neither used nor changed.

ADDRESS REGISTERS

Each address register and the stack pointer is 32 bits wide and holds a full 32 bit address. Address registers do not support byte sized operands. Therefore, when an address register is used as a source operand, either the low order word or the entire long word operand is used depending upon the operation size. When an address register is used as the destination operand, the entire register is affected regardless of the operation size. If the operation size is word, any other operands are sign extended to 32 bits before the operation is performed.

● STATUS REGISTER

The status register contains the interrupt mask (eight levels available) as well as the condition codes; extend (X), negative (N), zero (Z), overflow (V), and carry (C). Additional status bits indicate that the processor is in a trace (T) mode and/or in a supervisor (S) state.



● DATA ORGANIZATION IN MEMORY

Bytes are individually addressable with the high order byte having an even address the same as the word, as shown in Figure 9. The low order byte has an odd address that is one count higher than the word address. Instructions and multibyte data are accessed only on word (even byte) boundaries. If a long word datum is located at address n (n even), then the second word of that datum is located at address n + 2.

The data types supported by the HD68000 are: bit data, integer data of 8, 16, or 32 bits, 32-bit addresses and binary coded decimal data. Each of these data types is put in memory, as shown in Figure 10. The numbers indicate the order in which the data would be accessed from the processor.

■ BUS OPERATION

The following paragraphs explain control signal and bus operation during data transfer operations, bus arbitration, bus error and halt conditions, and reset operation.

● DATA TRANSFER OPERATIONS

- Transfer of data between devices involve the following leads:
 - (1) Address Bus A₁ through A₂₃
 - (2) Data Bus D₀ through D₁₅
 - (3) Control Signals

The address and data buses are separate parallel buses used to transfer data using an asynchronous bus structure. In all cycles, the bus master assumes responsibility for deskewing all signals it issues at both the start and end of a cycle. In addition, the bus master is responsible for deskewing the acknowledge and data signals from the slave device.

The following paragraphs explain the read, write, and read-modify-write cycles. The indivisible read-modify-write cycle is the method used by the HD68000 for interlocked multi-processor communications.

(NOTE) The terms **assertion** and **negation** will be used extensively. This is done to avoid confusion when dealing with a mixture of "active-low" and "active-high" signals. The term assert or assertion is used to indicate that a signal is active or true independent of whether that voltage is low or high. The term negate or negation is used to indicate that a signal is inactive or false.

Read Cycle

During a read cycle, the processor receives data from memory or a peripheral device. The processor reads bytes of data in all cases. If the instruction specifies a word (or double word) operation, the processor reads both bytes. When the instruction specifies byte operation, the processor uses an internal A₀ bit to determine which byte to read and then issues the data strobe required for that byte. For bytes operations, when the A₀ bit equals zero, the upper data strobe is issued. When the A₀ bit equals one, the lower data strobe is issued. When the data is received, the processor correctly positions it internally.

A word read cycle flow chart is given in Figure 11. A byte read cycle flow chart is given in Figure 12. Read cycle timing is given in Figure 13. Figure 14 details word and byte read cycle operations. Refer to these illustrations during the following detailed.

At state zero (S0) in the read cycle, the address bus (A_1 through A_{23}) is in the high impedance state. A function code is asserted on the function code output line (FC_0 through FC_2). The read/write (R/W) signal is switched high to indicate a read cycle. One half clock cycle later, at state 1, the address bus is released from the high impedance state. The function code outputs indicate which address space that this cycle will operate on.

In state 2, the address strobe (\overline{AS}) is asserted to indicate that there is a valid address on the address bus and the upper and lower data strobe (\overline{UDS} , \overline{LDS}) is asserted as required. The memory or peripheral device uses the address bus and the address strobe to determine if it has been selected. The selected device uses the read/write signal and the data strobe to place its information on the data bus. Concurrent with placing data on the data bus, the selected device asserts data transfer acknowledge (\overline{DTACK}).

Data transfer acknowledge must be present at the processor at the start of state 5 or the processor will substitute wait states for states 5 and 6. State 5 starts the synchronization of the

returning data transfer acknowledge. At the end of state 6 (beginning of state 7) incoming data is latched into an internal data bus holding register.

During state 7, address strobe and the upper and/or lower data strobes are negated. The address bus is held valid through state 7 to allow for static memory operation and signal skew. The read/write signal and the function code outputs also remain valid through state 7 to ensure a correct transfer operation. The slave device keeps its data asserted until it detects the negation of either the address strobe or the upper and/or lower data strobe. The slave device must remove its data and data transfer acknowledge within one clock period of recognizing the negation of the address or data strobes. Note that the data bus might not become free and data transfer acknowledge might not be removed until state 0 or 1.

When address strobe is negated, the slave device is released. Note that a slave device must remain selected as long as address strobe is asserted to ensure the correct functioning of the read-modify-write cycle.

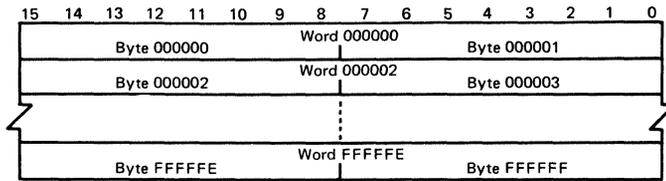


Figure 9 Word Organization in Memory

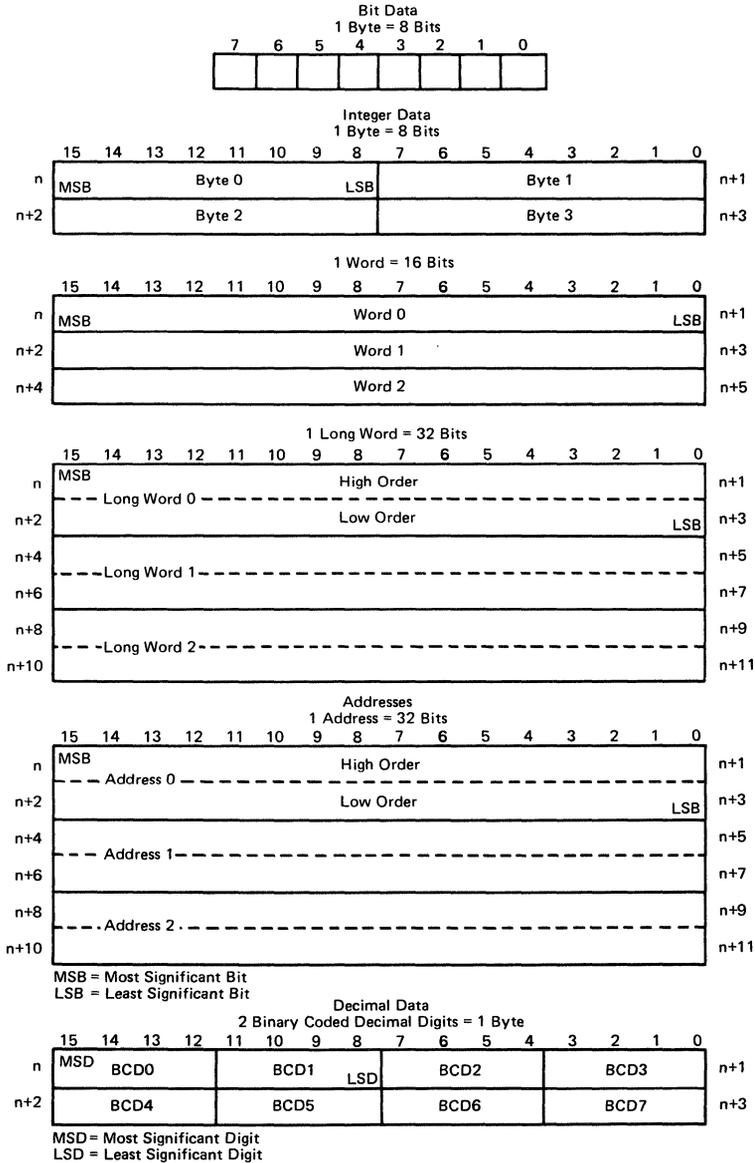


Figure 10 Data Organization in Memory

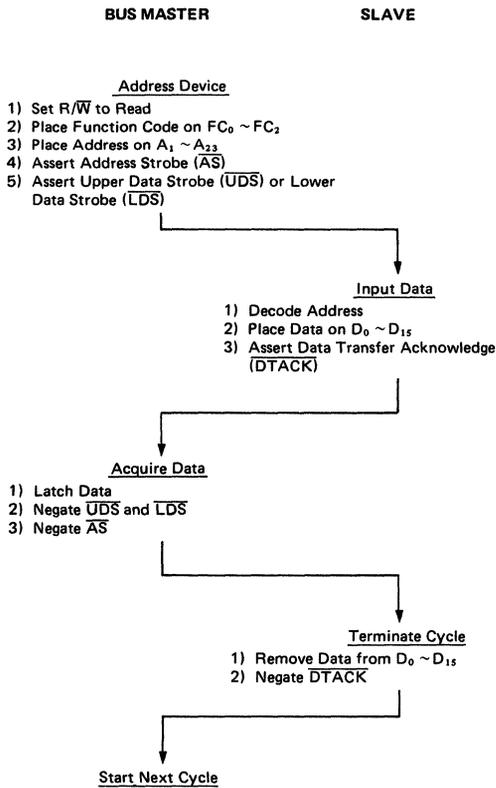


Figure 11 Word Read Cycle Flow Chart

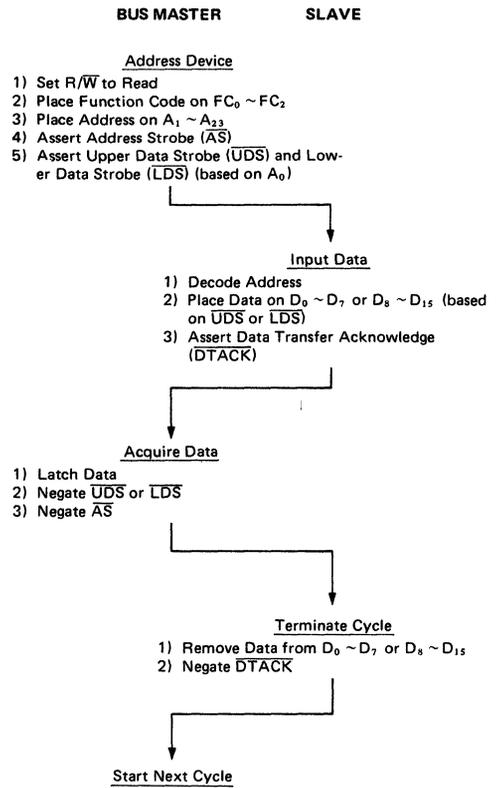


Figure 12 Byte Read Cycle Flow Chart

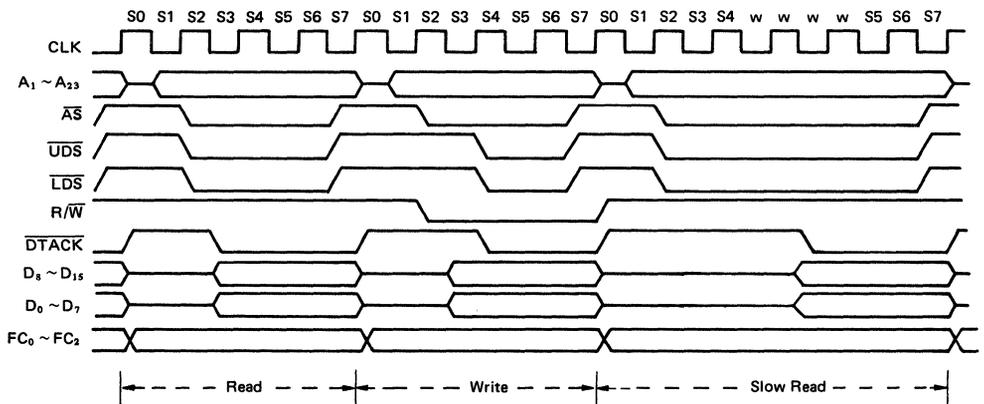


Figure 13 Read and Write Cycle Timing Diagram

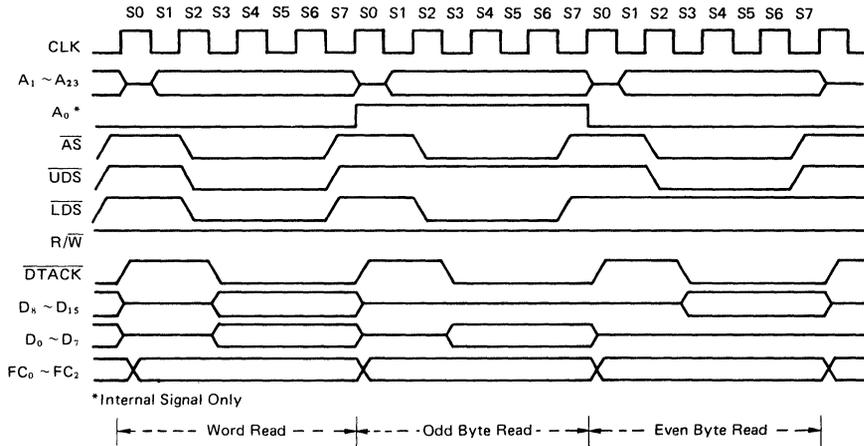


Figure 14 Word and Byte Read Cycle Timing Diagram

Write Cycle

During a write cycle, the processor sends data to memory or a peripheral device. The processor writes bytes of data in all cases. If the instruction specifies a word operation, the processor writes both bytes. When the instruction specifies a byte operation, the processor uses an internal A₀ bit to determine which byte to write and then issues the data strobe required for that byte. For byte operations, when the A₀ bit equals zero, the upper data strobe is issued. When the A₀ bit equals one, the lower data strobe is issued. A word write cycle flow chart is given in Figure 15. A byte write cycle flow chart is given in Figure 16. Write cycle timing is given in Figure 13. Figure 17 details word and byte write cycle operation. Refer to these illustrations during the following detailed discussion.

At state zero (S₀) in the write cycle, the address bus (A₁ through A₂₃) is in the high impedance state. A function code is asserted on the function code output line (FC₀ through FC₂).

(NOTE) The read/write (R/W) signal remains high until state 2 to prevent bus conflicts with preceding read cycles. The data bus is not driven until state 3.

One half clock later, at state 1, the address bus is released from the high impedance state. The function code outputs indicate which address space that this cycle will operate on.

In state 2, the address strobe (AS) is asserted to indicate that there is a valid address on the address bus. The memory or peripheral device uses the address bus and the address strobe to determine if it has been selected. During state 2, the read/write signal is switched low to indicate a write cycle. When external processor data bus buffers are required, the read/write line provides sufficient directional control. Data is not asserted during this state to allow sufficient turn around time for external data buffers (if used). Data is asserted onto the data bus during state 3.

In state 4, the data strobes are asserted as required to indicate that the data bus is stable. The selected device uses the

read/write signal and the data strobes to take its information from the data bus. The selected device asserts data transfer acknowledge (DTACK) when it has successfully stored the data.

Data transfer acknowledge must be present at the processor at the start of state 5 or the processor will substitute wait states for states 5 and 6. State 5 starts the synchronization of the returning data transfer acknowledge.

During state 7, address strobe and the upper and/or lower data strobes are negated. The address and data buses are held valid through state 7 to allow for static memory operation and signal skew. The read/write signal and the function code outputs also remain valid through state 7 to ensure a correct transfer operation. The slave device keeps its data transfer acknowledge asserted until it detects the negation of either the address strobe or the upper and/or lower data strobe. The slave device must remove its data transfer acknowledge within one clock period after recognizing the negation of the address or data strobes. Note that the processor releases the data bus at the end of state 7 but that data transfer acknowledge might not be removed until state 0 or 1. When address strobe is negated, the slave device is released.

Read-Modify-Write Cycle

The read-modify-write cycle performs a read, modifies the data in the arithmetic-logic unit, and writes the data back to the same address. In the HD68000 this cycle is indivisible in that the address strobe is asserted throughout the entire cycle. The test and set (TAS) instruction uses this cycle to provide meaningful communication between processors in a multiple processor environment. This instruction is the only instruction that uses the read-modify-write cycle and since the test and set instruction only operates on bytes, all read-modify-write cycles are byte operations. A read-modify-write cycle flow chart is given in Figure 18 and a timing diagram is given in Figure 19. Refer to these illustrations during the following detailed discus-

sions.

At state zero (S0) in the read-modify-write cycle, the address bus (A₁ through A₂₃) is in the high impedance state. A function code is asserted on the function code output line (FC₀ through FC₂). The read/write (R/W) signal is switched high to indicate a read cycle. One half clock cycle later, at state 1, the address bus is released from the high impedance state. The function code outputs indicate which address space that this cycle will operate on.

In state 2, the address strobe (AS) is asserted to indicate that there is a valid address on the address bus and the upper or lower data strobe (UDS, LDS) is asserted as required. The memory or peripheral device uses the address bus and the address strobe to determine if it has been selected. The selected device uses the read/write signal and the data strobe to place its information on the data bus. Concurrent with placing data on the data bus, the selected device asserts data transfer acknowledge (DTACK).

Data transfer acknowledge must be present at the processor at the start of state 5 or the processor will substitute wait states for states 5 and 6. State 5 starts the synchronization of the returning data transfer acknowledge. At the end of state 6 (beginning of state 7) incoming data is latched into an internal data bus holding register.

During state 7, the upper or lower data strobe is negated. The address bus, address strobe, read/write signal, and function code outputs remain as they were in preparation for the write portion of the cycle. The slave device keeps its data asserted until it detects the negation of the upper or lower data strobe. The slave device must remove its data and data transfer acknowledge within one clock period of recognizing the negation of the data strobes. Internal modification of data may occur from state 8 to state 11.

(NOTE) The read/write signal remains high until state 14 to prevent bus conflicts with the preceding read portion of the cycle and the data bus is not asserted by the processor until state 15.

In state 14, the read/write signal is switched low to indicate a write cycle. When external processor data bus buffers are required, the read/write line provides sufficient directional control. Data is not asserted during this state to allow sufficient turn around time for external data buffers (if used). Data is asserted onto the data bus during state 15.

In state 16, the data strobe is asserted as required to indicate that the data bus is stable. The selected device uses the read/write signal and the data strobe to take its information from the data bus. The selected device asserts data transfer acknowledge (DTACK) when it has successfully stored its data.

Data transfer acknowledge must be present at the processor at the start of state 17 or the processor will substitute wait states for states 17 and 18. State 17 starts the synchronization

of the returning data transfer acknowledge for the write portion of the cycle. The bus interface circuitry issues requests for subsequent internal cycles during state 18.

During state 19, address strobe and the upper or lower data strobe is negated. The address and data buses are held valid through state 19 to allow for static memory operation and signal skew. The read/write signal and the function code outputs also remain valid through state 19 to ensure a correct transfer operation. The slave device keeps its data transfer acknowledge asserted until it detects the negation of either the address strobe or the upper or lower data strobe. The slave device must remove its data transfer acknowledge within once clock period after recognizing the negation of the address or data strobes. Note that the processor releases the data bus at the end of state 19 but that data transfer acknowledge might not be removed until state 0 or 1. When address strobe is negated the slave device is released.

● BUS ARBITRATION

Bus arbitration is a technique used by master-type devices to request, be granted, and acknowledge bus mastership. In its simplest form, it consists of:

- (1) Asserting a bus mastership request.
- (2) Receiving a grant that the bus is available at the end of the current cycle.
- (3) Acknowledging that mastership has been assumed.

Figure 20 is a flow chart showing the detail involved in a request from a single device. Figure 21 is a timing diagram for the same operations. This technique allows processing of bus requests during data transfer cycles.

The timing diagram shows that the bus request is negated at the time that an acknowledge is asserted. This type of operation would be true for a system consisting of the processor and one device capable of bus mastership. In systems having a number of devices capable of bus mastership, the bus request line from each device is wire ORed to the processor. In this system, it is easy to see that there could be more than one bus request being made. The timing diagram shows that the bus grant signal is negated a few clock cycles after the transition of the acknowledge (BGACK) signal.

However, if the bus requests are still pending, the processor will assert another bus grant within a few clock cycles after it was negated. This additional assertion of bus grant allows external arbitration circuitry to select the next bus master before the current bus master has completed its requirements. The following paragraphs provide additional information about the three steps in the arbitration process.

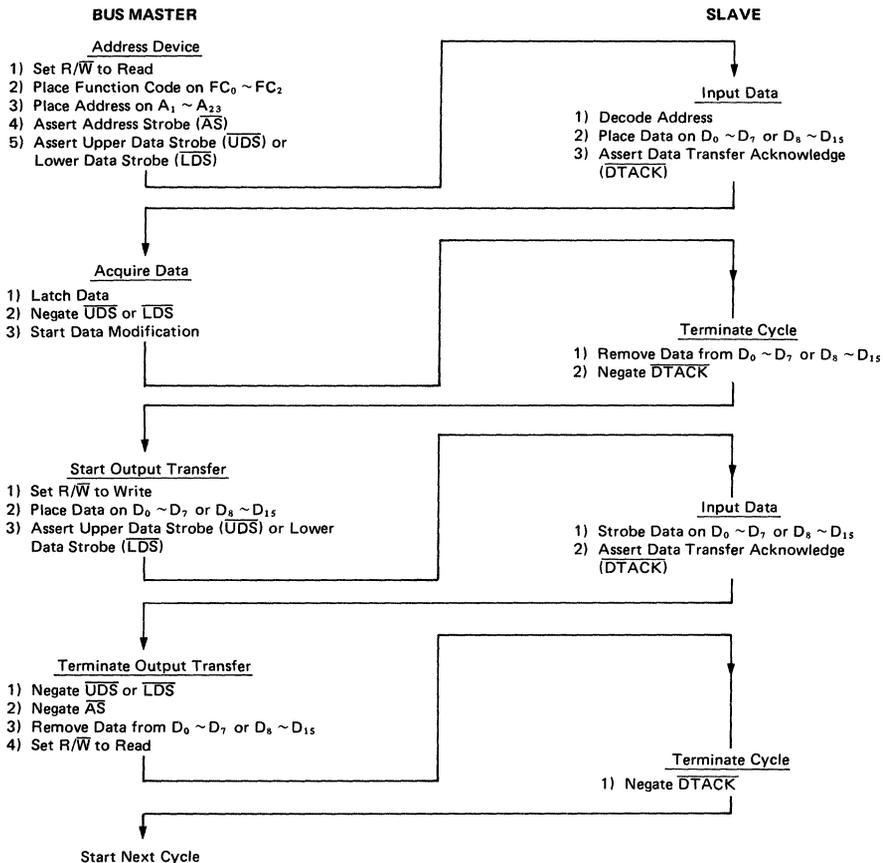


Figure 18 Read-Modify-Write Cycle Flow Chart

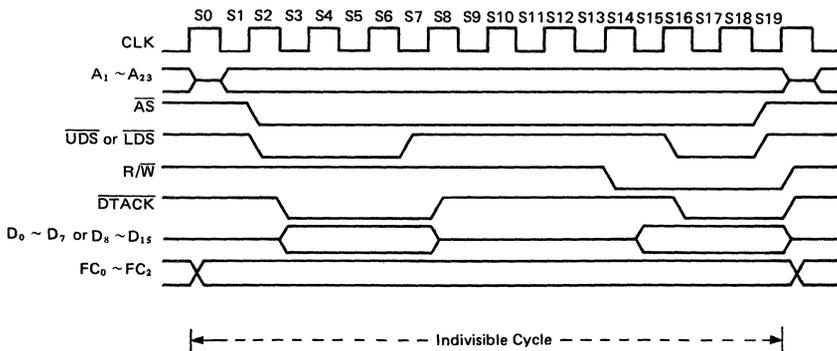


Figure 19 Read-Modify-Write Cycle Timing Diagram

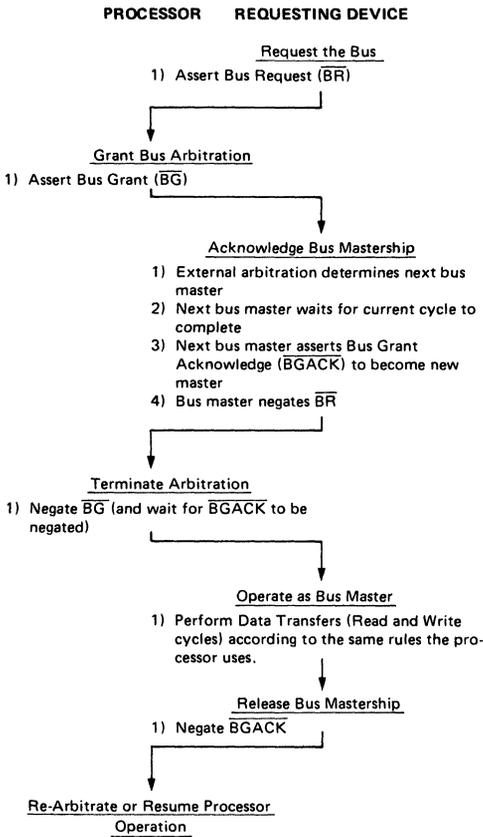


Figure 20 Bus Arbitration Cycle Flow Chart

Requesting the Bus

External devices capable of becoming bus masters request the bus by asserting the bus request (\overline{BR}) signal. This is a wire ORed signal (although it need not be constructed from open collector devices) that indicates to the processor that some external device requires control of the external bus. The processor is effectively at a lower bus priority level than the external device and will relinquish the bus after it has completed the last bus cycle it has started.

When no acknowledge is received before the bus request signal goes inactive, the processor will continue processing when it detects that the bus request is inactive. This allows ordinary processing to continue if the arbitration circuitry responded to noise inadvertently.

Receiving the Bus Grant

The processor asserts bus grant (\overline{BG}) as soon as possible. Normally this is immediately after internal synchronization. The only exception to this occurs when the processor has made an internal decision to execute the next bus cycle but has not progressed far enough into the cycle to have asserted the address strobe (\overline{AS}) signal. In this case, bus grant will not be asserted until one clock after address strobe is asserted to indicate to external devices that a bus cycle is being executed.

The bus grant signal may be routed through a daisy-chained network or through a specific priority-encoded network. The processor is not affected by the external method of arbitration as long as the protocol is obeyed.

Acknowledgement of Mastership

Upon receiving a bus grant, the requesting device waits until address strobe, data transfer acknowledge, and bus grant acknowledge are negated before issuing its own \overline{BGACK} . The negation of the address strobe indicates that the previous master has completed its cycle, the negation of bus grant acknowledge indicates that the previous master has released the bus. (While address strobe is asserted no device is allowed to "break into" a cycle.) The negation of data transfer acknowledge indicates the previous slave has terminated its connection to the previous master. Note that in some applications data

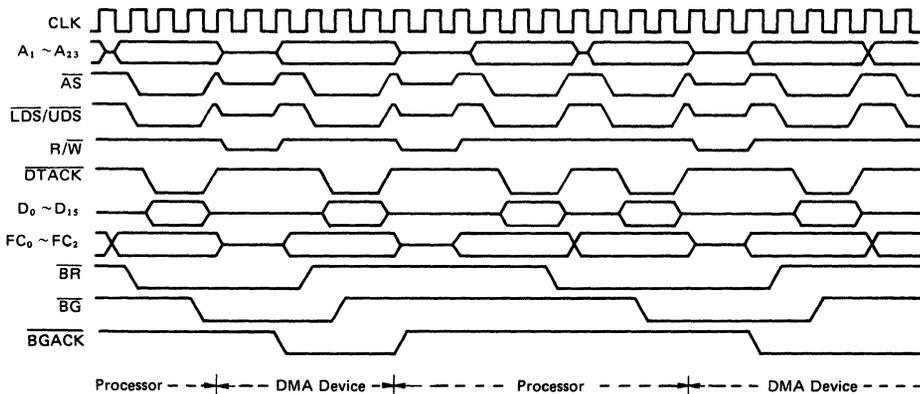


Figure 21 Bus Arbitration Cycle Timing Diagram

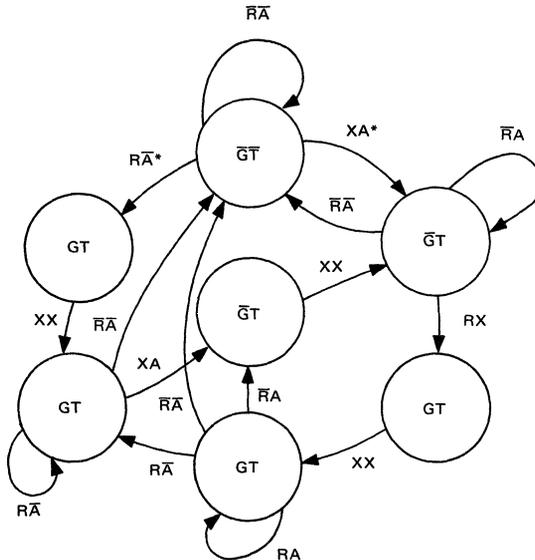
transfer acknowledge might not enter into this function. General purpose devices would then be connected such that they were only dependent on address strobe. When bus grant acknowledge is issued the device is bus master until it negates bus grant acknowledge. Bus grant acknowledge should not be negated until after the bus cycle(s) is (are) completed. Bus mastership is terminated at the negation of bus grant acknowledge.

The bus request from the granted device should be dropped after bus grant acknowledge is asserted. If a bus request is still pending, another bus grant will be asserted within a few clocks of the negation of bus grant. Refer to Bus Arbitration Control section. Note that the processor does not perform any external bus cycles before it re-asserts bus grant.

• BUS ARBITRATION CONTROL

The bus arbitration control unit in the HD68000 is implemented with a finite state machine. A state diagram of this machine is shown in Figure 22. All asynchronous signals to the HD68000 are synchronized before being used internally. This synchronization is accomplished in a maximum of one cycle of the system clock, assuming that the asynchronous input setup time (#47) has been met (see Figure 23). The input signal is sampled on the falling edge of the clock and is valid internally after the next falling edge.

As shown in Figure 22, input signals labeled R and A are internally synchronized on the bus request and bus grant



R = Bus Request Internal
 A = Bus Grant Acknowledge Internal
 G = Bus Grant
 T = Three-State Control to Bus Control Logic**
 X = Don't Care

* State machine will not change state if bus is in S0. Refer to BUS ARBITRATION CONTROL for additional information.

** The address bus will be placed in the high impedance state if T is asserted and A-bar is negated.

Figure 22 State Diagram of HD68000 Bus Arbitration Unit

acknowledge pins respectively. The bus grant output is labeled G and the internal three-state control signal T. If T is true, the address, data, function code line, and control buses are placed in a high-impedance state when A-bar is negated. All signals are shown in positive logic (active high) regardless of their true active voltage level.

State changes (valid outputs) occur on the next rising edge after the internal signal is valid.

A timing diagram of the bus arbitration sequence during a processor bus cycle is shown in Figure 24. The bus arbitration sequence while the bus is inactive (i.e., executing internal operations such as a multiply instruction) is shown in Figure 25.

If a bus request is made at a time when the MPU has already begun a bus cycle but A-bar has not been asserted (bus state S0), G-bar will not be asserted on the next rising edge. Instead, G-bar will be delayed until the second rising edge following its internal assertion. This sequence is shown in Figure 26.

• BUS ERROR AND HALT OPERATION

In a bus architecture that requires a handshake from an external device, the possibility exists that the handshake might not occur. Since different systems will require a different maximum response time, a bus error input is provided. External circuitry must be used to determine the duration between address strobe and data transfer acknowledge before issuing a bus error signal. When a bus error signal is received, the processor has two options: initiate a bus error exception sequence or try running the bus cycle again.

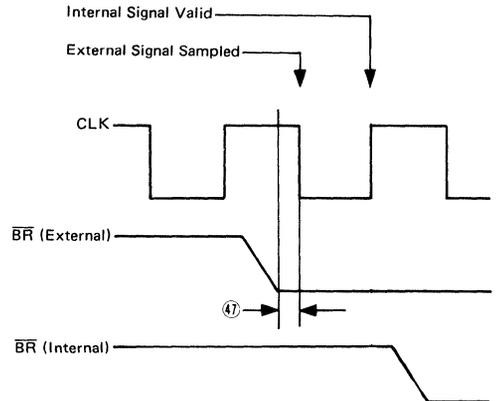


Figure 23 Timing Relationship of External Asynchronous Inputs to Internal Signals

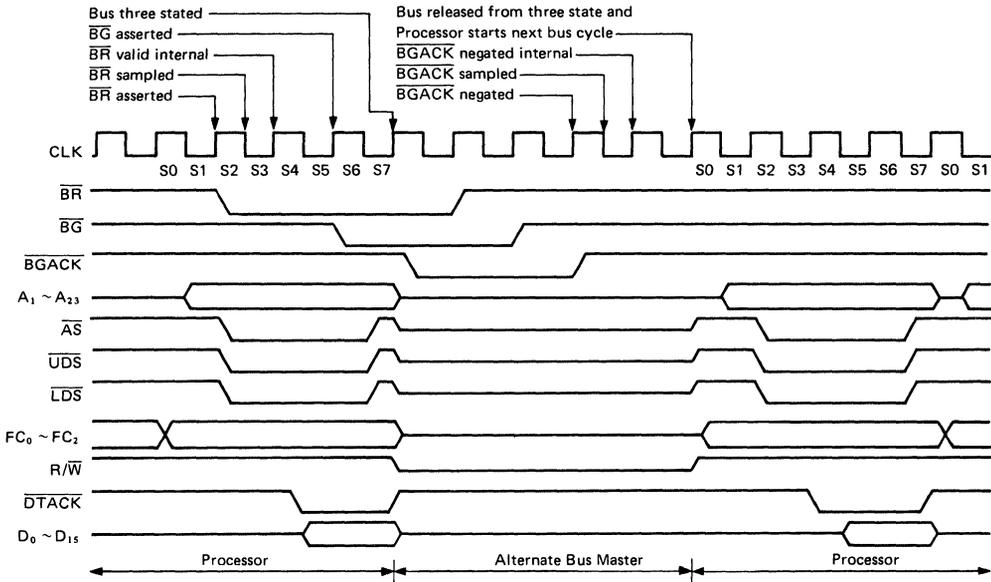


Figure 24 Bus Arbitration During Processor Bus Cycle

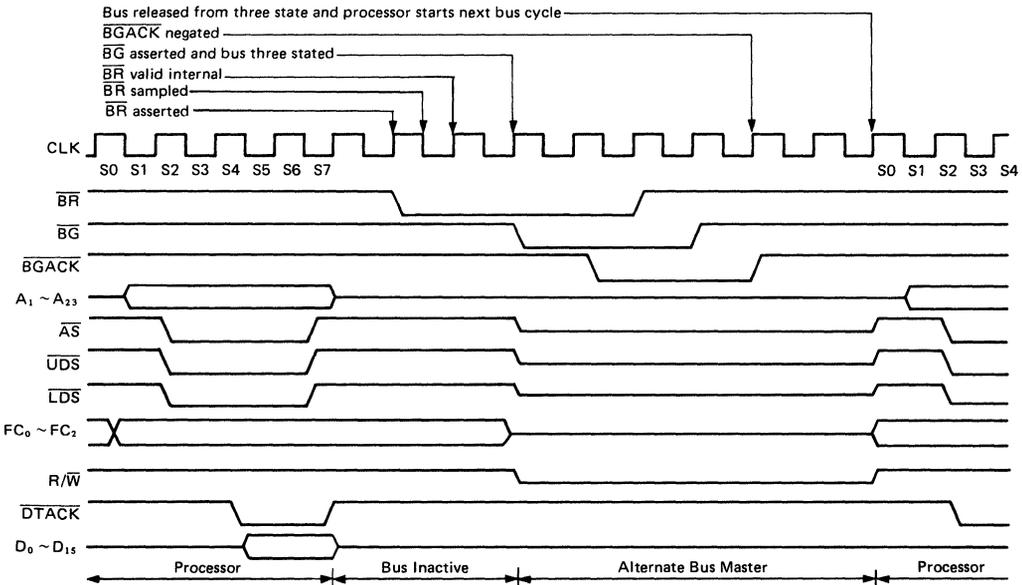


Figure 25 Bus Arbitration with Bus Inactive

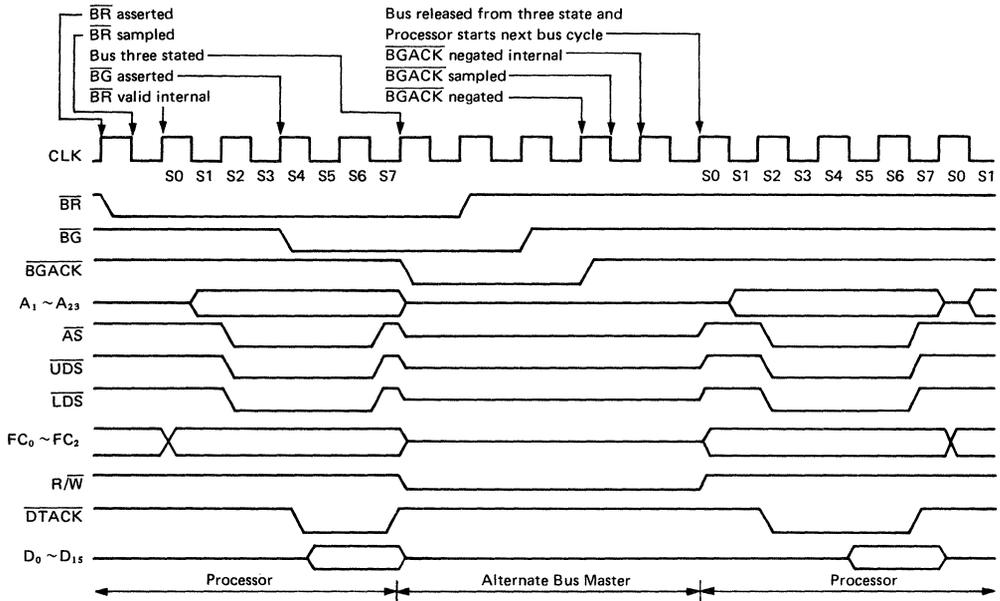


Figure 26 Bus Arbitration During Processor Bus Cycle Special Case

Exception Sequence

When the bus error signal is asserted, the current bus cycle is terminated. If \overline{BERR} is asserted before the falling edge of S4, \overline{AS} will be negated in S7 in either a read or write cycle. As long as \overline{BERR} remains asserted, the data and address buses will be in the high-impedance state. When \overline{BERR} is negated, the processor will begin stacking for exception processing. Figure 27 is a timing diagram for the exception sequence. The sequence is composed of the following elements.

- (1) Stacking the program counter and status register
- (2) Stacking the error information
- (3) Reading the bus error vector table entry
- (4) Executing the bus error handler routine

The stacking of the program counter and the status register is the same as if an interrupt had occurred. Several additional items are stacked when a bus error occurs. These items are used to determine the nature of the error and correct it, if possible. The bus error vector is vector number two located at address \$000008. The processor loads the new program counter from this location. A software bus error handler routine is then executed by the processor. Refer to **EXCEPTION PROCESSING** for additional information.

Re-Running the Bus Cycle

When, during a bus cycle, the processor receives a bus error signal and the halt pin is being driven by an external device, the processor enters the re-run sequence. Figure 28 is a timing diagram for re-running the bus cycle.

The processor terminates the bus cycle, then puts the address and data output lines in the high-impedance state. The processor remains "halted," and will not run another bus cycle until the halt signal is removed by external logic. Then the processor will re-run the previous bus cycle using the same address, the same function codes, the same data (for a write operation), and the same controls. The bus error signal should be removed at least one clock cycle before the halt signal is removed.

(NOTE) The processor will not re-run a read-modify-write cycle. This restriction is made to guarantee that the entire cycle runs correctly and that the write operation of a Test-and-Set operation is performed without ever releasing \overline{AS} . If \overline{BERR} and \overline{HALT} are asserted during a read-modify-write bus cycle, a bus error operation results.

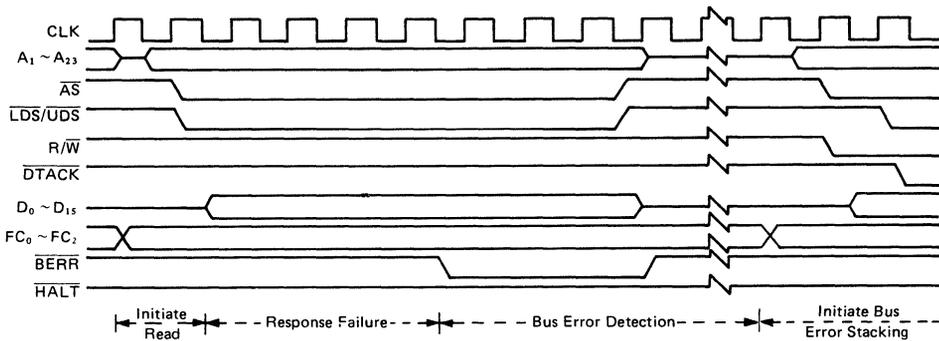


Figure 27 Bus Error Timing Diagram

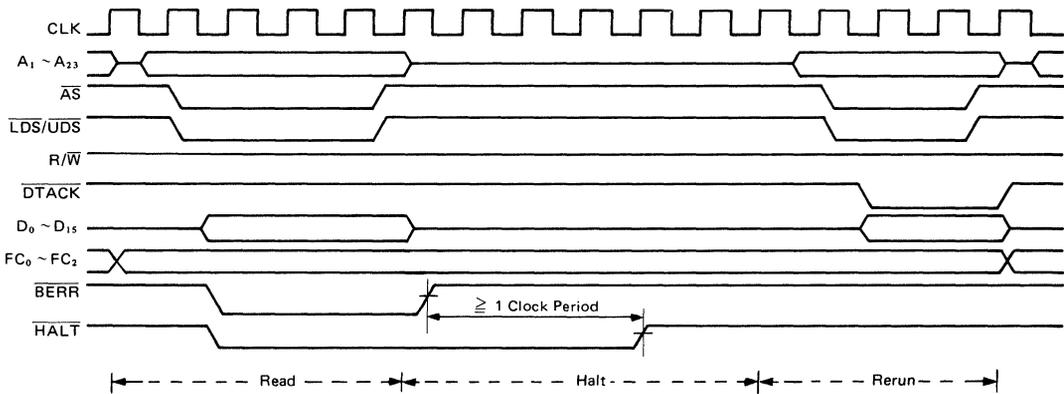


Figure 28 Re-Run Bus Cycle Timing Information

The processor terminates the bus cycle, then puts the address, data and function code output lines in the high-impedance state. The processor remains "halted," and will not run another bus cycle until the halt signal is removed by external logic. Then the processor will re-run the previous bus cycle using the same address, the same function codes, the same data (for a write operation), and the same controls. The bus error signal should be removed before the halt signal is removed.

Halt Operation with No Bus Error

The halt input signal to the HD68000 perform a Halt/Run/Single-Step function in a similar fashion to the HMCS6800 halt function. The halt and run modes are somewhat self explanatory in that when the halt signal is constantly active the processor "halts" (does nothing) and when the halt signal is constantly inactive the processor "runs" (does something).

The single-step mode is derived from correctly timed transitions on the halt signal input. It forces the processor to execute a single bus cycle by entering the "run" mode until the processor starts a bus cycle then changing to the "halt" mode. Thus, the single-step mode allows the user to proceed through (and therefore debug) processor operations one bus cycle at a time.

Figure 29 details the timing required for correct single-step operations. Some care must be exercised to avoid harmful interactions between the bus error signal and the halt pin when using the single cycle mode as a debugging tool. This is also true of interactions between the halt and reset lines since these can reset the machine.

When the processor completes a bus cycle after recognizing that the halt signal is active, most three-state signals are put in the high-impedance state. These include:

- (1) Address lines
- (2) Data lines

This is required for correct performance of the re-run bus cycle operation.

While the processor is honoring the halt request, bus arbitration performs as usual. That is, halting has no effect on bus arbitration. It is the bus arbitration function that removes the control signals from the bus.

The halt function and the hardware trace capability allow the hardware debugger to trace single bus cycles or single instructions at a time. These processor capabilities, along with a software debugging package, give total debugging flexibility.

Double Bus Faults

When a bus error exception occurs, the processor will attempt to stack several words containing information about the state of the machine. If a bus error exception occurs during the stacking operation, there have been two bus errors in a row. This is commonly referred to as a double bus fault. When a double bus fault occurs, the processor will halt. Once a bus error exception has occurred, any bus error exception occurring before the execution of the next instruction constitutes a double bus fault.

Note that a bus cycle which is re-run does not constitute a bus error exception, and does not contribute to a double bus

fault. Note also that this means that as long as the external hardware requests it, the processor will continue to re-run the same bus cycle.

The bus error pin also has an effect on processor operation after the processor receives an external reset input. The processor reads the vector table after a reset to determine the address to start program execution. If a bus error occurs while reading the vector table (or at any time before the first instruction is executed), the processor reacts as if a double bus fault has occurred and it halts. Only an external reset will start a halted processor.

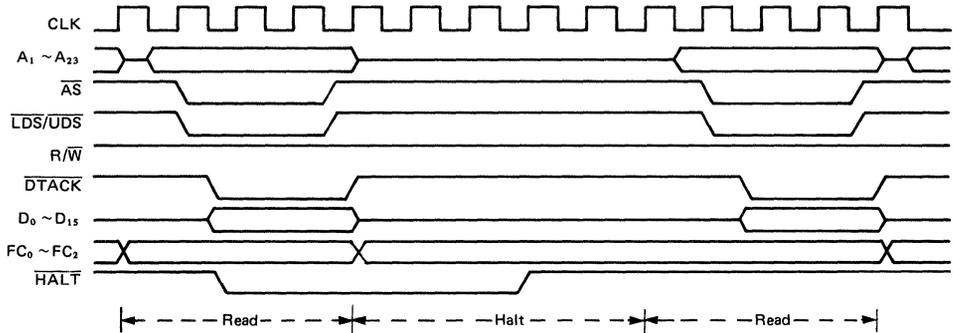


Figure 29 Halt Signal Timing Characteristics

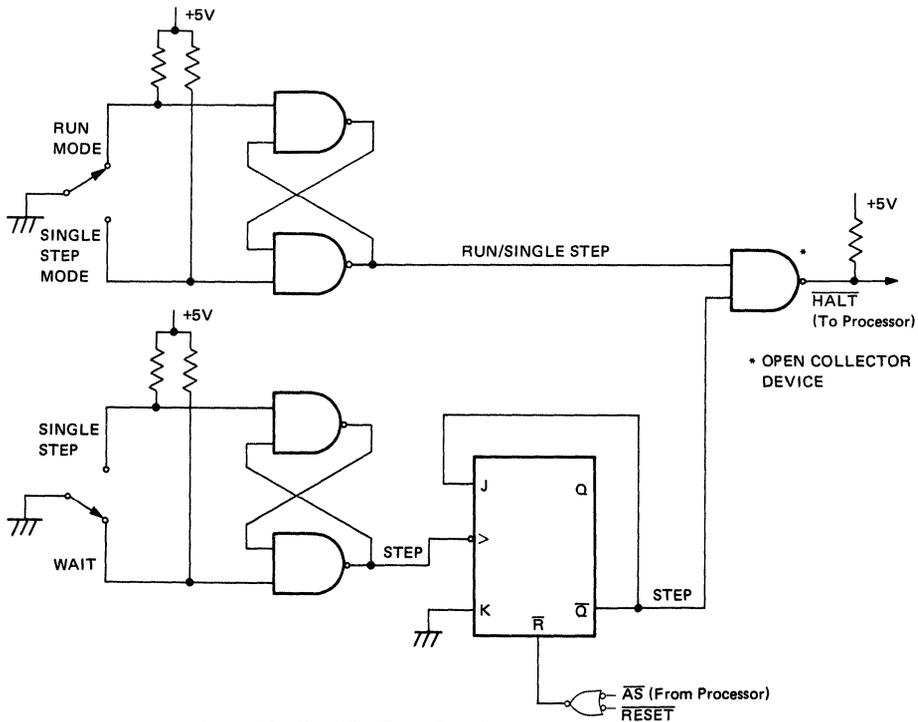


Figure 30 Simplified Single-Step Circuit

THE RELATIONSHIP OF \overline{DTACK} , \overline{BERR} , AND \overline{HALT}

In order to properly control termination of a bus cycle for a run or a bus error condition, \overline{DTACK} , \overline{BERR} , and \overline{HALT} could be asserted and negated on the rising edge of the D68000 clock. This will assure that when two signals are asserted simultaneously, the required setup time (#47) for \overline{DTACK} and \overline{BERR} will be met during the same bus state.

This, or some equivalent precaution, should be designed external to the HD68000. Parameter #48 is intended to ensure its operation in a totally asynchronous system, and may be ignored if the above conditions are met.

The preferred bus cycle terminations may be summarized as follows (case numbers refer to Table 4):

- Normal Termination:** \overline{DTACK} occurs first (case 1).
- Abort Termination:** \overline{HALT} is asserted at the same time or before \overline{DTACK} and \overline{BERR} remains negated (cases 2 and 3).
- Bus Error Termination:** \overline{BERR} is asserted in lieu of, at the same time, or before \overline{DTACK} (case 4); \overline{BERR} is negated at the same time or after \overline{DTACK} .
- Re-Run Termination:** \overline{HALT} and \overline{BERR} are asserted in lieu of, at the same time, or before \overline{DTACK} (cases 6 and 7); \overline{HALT} must be held at least one cycle after \overline{BERR} . Case 5 indicates

\overline{BERR} may precede \overline{HALT} which allows fully asynchronous assertion.

Table 4 details the resulting bus cycle termination under various combinations of control signal sequences. The negation of these same control signals under several conditions is shown in Table 5 (\overline{DTACK} is assumed to be negated normally in all cases; for best results, both \overline{DTACK} and \overline{BERR} should be negated when address strobe is negated.)

Example A: A system uses a watch-dog timer to terminate accesses to un-populated address space. The timer asserts \overline{DTACK} and \overline{BERR} simultaneously after time-out. (case 4)

Example B: A system uses error detection on RAM contents. Designer may (a) delay \overline{DTACK} until data verified, and return \overline{BERR} and \overline{HALT} simultaneously to re-run error cycle (case 6), or if valid, return \overline{DTACK} ; (b) delay \overline{DTACK} until data verified, and return \overline{BERR} at same time as \overline{DTACK} if data in error (case 4); (c) return \overline{DTACK} prior to data verification, as described in previous section. If data invalid, \overline{BERR} is asserted (case 1) in next cycle. Error-handling software must know how to recover error cycle.

Table 4 \overline{DTACK} , \overline{BERR} , \overline{HALT} Assertion Results

Case No.	Control Signal	Asserted on Rising Edge of State		Result
		N	N + 2	
1	\overline{DTACK} \overline{BERR} \overline{HALT}	A NA NA	S X X	Normal cycle terminate and continue.
2	\overline{DTACK} \overline{BERR} \overline{HALT}	A NA A	S X S	Normal cycle terminate and halt. Continue when \overline{HALT} removed.
3	\overline{DTACK} \overline{BERR} \overline{HALT}	NA NA A	A NA S	Normal cycle terminate and halt. Continue when \overline{HALT} removed.
4	\overline{DTACK} \overline{BERR} \overline{HALT}	X A NA	X S NA	Terminate and take bus error trap.
5	\overline{DTACK} \overline{BERR} \overline{HALT}	NA A NA	X S A	Terminate and re-run.
6	\overline{DTACK} \overline{BERR} \overline{HALT}	X A A	X S S	Terminate and re-run when \overline{HALT} removed.
7	\overline{DTACK} \overline{BERR} \overline{HALT}	NA NA A	X A S	Terminate and re-run when \overline{HALT} removed.

Legend:
 N - The number of the current even bus state (e.g., S4, S6, etc.)
 A - Signal is asserted in this bus state
 NA - Signal is not asserted in this state
 X - Don't care
 S - Signal was asserted in previous state and remains asserted in this state

Table 5 BERR and HALT Negation Results

Conditions of Termination in Table A	Control Signal	Negated on Rising Edge of State		Results — Next Cycle
		N	N + 2	
Bus Error	$\overline{\text{BERR}}$ $\overline{\text{HALT}}$	● or ●	●	Takes bus error trap.
Re-run	$\overline{\text{BERR}}$ $\overline{\text{HALT}}$	● or ●	●	Illegal sequence; usually traps to vector number 0.
Re-run	$\overline{\text{BERR}}$ $\overline{\text{HALT}}$	●	●	Re-runs the bus cycle.
Normal	$\overline{\text{BERR}}$ $\overline{\text{HALT}}$	● or ●	●	May lengthen next cycle.
Normal	$\overline{\text{BERR}}$ $\overline{\text{HALT}}$	● or none	●	If next cycle is started it will be terminated as a bus error.

• ASYNCHRONOUS VERSUS SYNCHRONOUS OPERATION

ASYNCHRONOUS OPERATION

To achieve clock frequency independence at a system level, the HD68000 can be used in an asynchronous manner. This entails using only the bus handshake lines (AS, UDS, LDS, DTACK, BERR, HALT, and VPA) to control the data transfer. Using this method, AS signals the start of a bus cycle and the data strobes are used as a condition for valid data on a write cycle. The slave device (memory or peripheral) then responds by placing the requested data on the data bus for a read cycle or latching data on a write cycle and asserting the data transfer acknowledge signal (DTACK) to terminate the bus cycle. If no slave responds or the access is invalid, external control logic asserts the $\overline{\text{BERR}}$, or $\overline{\text{BERR}}$ and $\overline{\text{HALT}}$, signal to abort or re-run the bus cycle.

The DTACK signal is allowed to be asserted before the data from a slave device is valid on a read cycle. The length of time that DTACK may precede data is given as parameter #31 and it must be met in any asynchronous system to insure that valid data is latched into the processor. Notice that there is no maximum time specified from the assertion of AS to the assertion of DTACK. This is because the MPU will insert wait cycles of one clock period each until DTACK is recognized.

The BERR signal is allowed to be asserted after the DTACK signal is asserted. BERR must be asserted within the time given as parameter #48 after DTACK is asserted in any asynchronous system to insure proper operation. If this maximum delay time is violated, the processor may exhibit erratic behavior.

SYNCHRONOUS OPERATION

To allow for those systems which use the system clock as a signal to generate DTACK and other asynchronous inputs, the asynchronous input setup time is given as parameter #47. If this setup is met on an input, such as DTACK, the processor is guaranteed to recognize that signal on the next falling edge of the system clock. However, the converse is not true — if the input signal does not meet the setup time it is not guaranteed not to be recognized. In addition, if DTACK is recognized on a falling edge, valid data will be latched into the processor (on a read cycle) on the next falling edge provided that the data meets the setup time given as parameter #27. Given this, parameter #31 may be ignored. Note that if DTACK is asserted, with the required setup time, before the falling edge of S4, no wait status will be incurred and the bus cycle will run at its maximum speed of four clock periods.

In order to assure proper operation in a synchronous system when BERR is asserted after DTACK, BERR must meet the setup time parameter #27A prior to the falling edge of the clock one clock cycle after DTACK was recognized. This setup time is critical to proper operation, and the HD68000 may exhibit erratic behavior if it is violated.

(NOTE)

During an active bus cycle, VPA and BERR are sampled on every falling edge of the clock starting with S0. DTACK is sampled on every falling edge of the clock starting with S4 and data is latched on the falling edge of S6 during a read. The bus cycle will then be terminated in S7 except when BERR is asserted in the absence of DTACK, in which case it will terminate one clock cycle later in S9.

• RESET OPERATION

The reset signal is a bidirectional signal that allows either the processor or an external signal to reset the system. Figure 31 is a timing diagram for reset operations. Both the halt and reset lines must be applied to ensure total reset of the processor.

When the reset and halt lines are driven by an external device, it is recognized as an entire system reset, including the processor. The processor responds by reading the reset vector table entry (vector number zero, address \$000000) and loads it into the supervisor stack pointer (SSP). Vector table entry number one at address \$000004 is read next and loaded into the program counter. The processor initializes the status register to an interrupt level of seven. No other registers are affected by the reset sequence.

When a RESET instruction is executed, the processor drives the reset pin for 124 clock pulses. In this case, the processor is trying to reset the rest of the system. Therefore, there is no effect on the internal state of the processor. All of the processor's internal registers and the status register are unaffected by the execution of a RESET instruction. All external devices connected to the reset line should be reset at the completion of the RESET instruction.

Asserting the Reset and Halt pins for 10 clock cycles will cause a processor reset, except when VCC is initially applied to the processor. In this case, an external reset must be applied for 100 milliseconds.

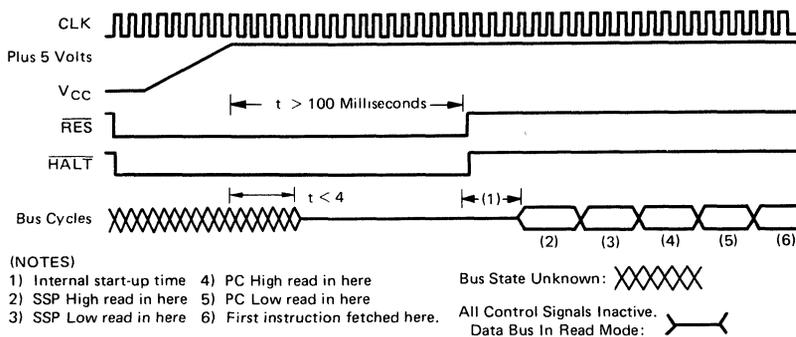


Figure 31 Reset Operation Timing Diagram

■ PROCESSING STATES

This section describes the HD68000 which are outside the normal processing associated with the execution of instructions. The functions of the bits in the supervisor portion of the status register are covered: the supervisor/user bit, the trace enable bit, and the processor interrupt priority mask. Finally, the sequence of memory references and actions taken by the processor on exception conditions is detailed.

The HD68000 is always in one of three processing states: normal, exception, or halted. The normal processing state is that associated with instruction execution; the memory references are to fetch instructions and operands, and to store results. A special case of the normal state is the stopped state which the processor enters when a STOP instruction is executed. In this state, no further memory references are made.

The exception processing state is associated with interrupts, trap instructions, tracing and other exceptional conditions. The exception may be internally generated by an instruction or by an unusual condition arising during the execution of an instruction. Externally, exception processing can be forced by an interrupt, by a bus error, or by a reset. Exception processing is designed to provide an efficient context switch so that the processor may handle unusual conditions.

The halted processing state is an indication of catastrophic hardware failure. For example, if during the exception processing of a bus error another bus error occurs, the processor assumes that the system is unusable and halts. Only an external reset can restart a halted processor. Note that a processor in the stopped state is not in the halted state, nor vice versa.

PROCESSING STATES

NORMAL	INSTRUCTION EXECUTION (INCLUDING STOP)
EXCEPTION	INTERRUPTS TRAPS TRACING ETC.
HALTED	HARDWARE HALT DOUBLE BUS FAULT

● PRIVILEGE STATES

The processor operates in one of two states of privilege: the "user" state or the "supervisor" state. The privilege state determines which operations are legal, is used by the external memory management device to control and translate accesses, and is used to choose between the supervisor stack pointer and the user stack pointer in instruction references.

The privileges state is a mechanism for providing security in a computer system. Programs should access only their own code and data areas, and ought to be restricted from accessing information which they do not need and must not modify.

The privilege mechanism provides security by allowing most programs to execute in user state. In this state, the accesses are controlled, and the effects on other parts of the system are limited. The operating system executes in the supervisor state, has access to all resources, and performs the overhead tasks for the user state programs.

SUPERVISOR STATE

The supervisor state is the higher state of privilege. For instruction execution, the supervisor state is determined by the S-bit of the status register; if the S-bit is asserted (high), the processor is in the supervisor state. All instructions can be executed in the supervisor state. The bus cycles generated by instructions executed in the supervisor state are classified as supervisor references. While the processor is in the supervisor privilege state, those instructions which use either the system stack pointer implicitly or address register seven explicitly access the supervisor stack pointer.

All exception processing is done in the supervisor state, regardless of the setting of the S-bit. The bus cycles generated during exception processing are classified as supervisor references. All stacking operations during exception processing use the supervisor stack pointer.

USER STATE

The user state is the lower state of privilege. For instruction execution, the user state is determined by the S-bit of the status register; if the S-bit is negated (low), the processor is executing instructions in the user state.

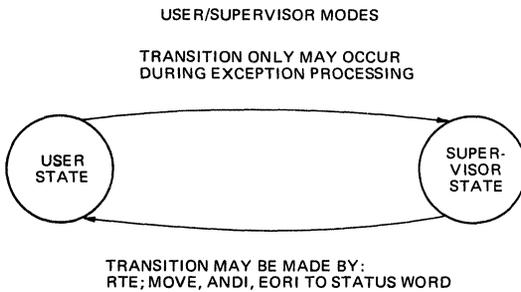
Most instructions execute the same in user state as in the supervisor state. However, some instructions which have important system effects are made privileged. User programs are not permitted to execute the STOP instruction, or the

RESET instruction. To ensure that a user program cannot enter the supervisor state except in a controlled manner, the instructions which modify the whole status register are privileged. To aid in debugging programs which are to be used as operating systems, the move to user stack pointer (MOVE USP) and move from user stack pointer (MOVE from USP) instructions are also privileged.

The bus cycles generated by an instruction executed in user state are classified as user state references. This allows an external memory management device to translate the address and to control access to protected portions of the address space. While the processor is in the user privilege state, those instructions which use either the system stack pointer implicitly, or address register seven explicitly, access the use stack pointer.

PRIVILEGE STATE CHANGES

Once the processor is in the user state and executing instructions, only exception processing can change the privilege state. During exception processing, the current setting of the S-bit of the status register is saved and the S-bit is asserted, putting the processing in the supervisor state. Therefore, when instruction execution resumes at the address specified to process the exception, the processor is in the supervisor privilege state.



REFERENCE CLASSIFICATION

When the processor makes a reference, it classifies the kind of reference being made, using the encoding on the three function code output lines. This allows external translation of addresses, control of access, and differentiation of special processor states, such as interrupt acknowledge. Table 6 lists the classification of references.

Table 6 Reference Classification

Function Code Output			Reference Class
FC ₂	FC ₁	FC ₀	
0	0	0	(Unassigned)
0	0	1	User Data
0	1	0	User Program
0	1	1	(Unassigned)
1	0	0	(Unassigned)
1	0	1	Supervisor Data
1	1	0	Supervisor Program
1	1	1	Interrupt Acknowledge

• **EXCEPTION PROCESSING**

Before discussing the details of interrupts, traps, and tracing, a general description of exception processing is in order. The processing of an exception occurs in four steps, with variations for different exception causes. During the first step, a temporary copy of the status register is made, and the status register is set for exception processing. In the second step the exception vector is determined, and the third step is the saving of the current processor context. In the fourth step a new context is obtained, and the processor switches to instruction processing.

EXCEPTION VECTORS

Exception vectors are memory locations from which the processor fetches the address of a routine which will handle that exception. All exception vectors are two words in length (Figure 32), except for the reset vector, which is four words. All exception vectors lie in the supervisor data space, except for the reset vector which is in the supervisor program space. A vector number is an eight-bit number which, when multiplied by four, gives the address of an exception vector. Vector numbers are generated internally or externally depending on the cause of the exception. In the case of interrupts, during the interrupt acknowledge bus cycle, a peripheral provides an 8-bit vector number (Figure 33) to the processor on data bus lines D₀ through D₇. The processor translates the vector number into a full 24-bit address, as shown in Figure 34. The memory layout for exception vectors is given in Table 7.

As shown in Table 7, the memory layout is 512 words long (1024 bytes). It starts at address 0 and proceeds through address 1023. This provides 255 unique vectors; some of these are reserved for TRAPS and other system functions. Of the 255, there are 192 reserved for user interrupt vectors. However, there is no protection on the first 64 entries, so user interrupt vectors may overlap at the discretion of the systems designer.

KINDS OF EXCEPTIONS

Exceptions can be generated by either internal or external causes. The externally generated exceptions are the interrupts and the bus error and reset requests. The interrupts are requests from peripheral devices for processor action while the bus error and reset inputs are used for access control and processor restart. The internally generated exceptions come from instructions, or from address error or tracing. The trap (TRAP), trap on overflow (TRAPV), check register against bounds (CHK) and divide (DIV) instructions all can generate exceptions as part of their instruction execution. In addition, illegal instructions, word fetches from odd addresses and privilege violations cause exceptions. Tracing behaves like a very high priority, internally generated interrupt after each instruction execution.

EXCEPTION PROCESSING SEQUENCE

Exception processing occurs in four identifiable steps. In the first step, an internal copy is made of the status register. After the copy is made, the S-bit is asserted, putting the processor into the supervisor privilege state. Also, the T-bit is negated which will allow the exception handler to execute unhindered by tracing. For the reset and interrupt exceptions, the interrupt priority mask is also updated.

In the second step, the vector number of the exception is determined. For interrupts, the vector number is obtained by a processor fetch, classified as an interrupt acknowledge. For all other exceptions, internal logic provides the vector number. This vector number is then used to generate the address of the exception vector.

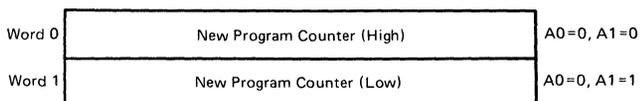
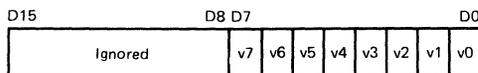


Figure 32 Exception Vector Format



Where:
 v7 is the MSB of the Vector Number
 v0 is the LSB of the Vector Number

Figure 33 Peripheral Vector Number Format

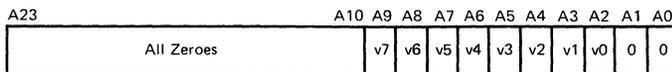


Figure 34 Address Translated From 8-Bit Vector Number

Table 7 Exception Vector Assignment

Vector Number(s)	Address			Assignment
	Dec	Hex	Space	
0	0	000	SP	Reset: Initial SSP
—	4	004	SP	Reset: Initial PC
2	8	008	SD	Bus Error
3	12	00C	SD	Address Error
4	16	010	SD	Illegal Instruction
5	20	014	SD	Zero Divide
6	24	018	SD	CHK Instruction
7	28	01C	SD	TRAPV Instruction
8	32	020	SD	Privilege Violation
9	36	024	SD	Trace
10	40	028	SD	Line 1010 Emulator
11	44	02C	SD	Line 1111 Emulator
12*	48	030	SD	(Unassigned, reserved)
13*	52	034	SD	(Unassigned, reserved)
14*	56	038	SD	(Unassigned, reserved)
15	60	03C	SD	Uninitialized Interrupt Vector
16 ~ 23*	64	04C	SD	(Unassigned, reserved)
	95	05F		
24	96	060	SD	Spurious Interrupt
25	100	064	SD	Level 1 Interrupt Autovector
26	104	068	SD	Level 2 Interrupt Autovector
27	108	06C	SD	Level 3 Interrupt Autovector
28	112	070	SD	Level 4 Interrupt Autovector
29	116	074	SD	Level 5 Interrupt Autovector
30	120	078	SD	Level 6 Interrupt Autovector
31	124	07C	SD	Level 7 Interrupt Autovector
32 ~ 47	128	080	SD	TRAP Instruction Vectors
	191	0BF		
48 ~ 63*	192	0C0	SD	(Unassigned, reserved)
	255	0FF		
64 ~ 255	256	100	SD	User Interrupt Vectors
	1023	3FF		

SP: Supervisor program, SD: Supervisor data

* Vector numbers 12, 13, 14, 16 through 23 and 48 through 63 are reserved for future enhancements by Hitachi. No user peripheral devices should be assigned these numbers.

MULTIPLE EXCEPTIONS

These paragraphs describe the processing which occurs when multiple exceptions arise simultaneously. Exceptions can be grouped according to their occurrence and priority. The Group 0 exceptions are reset, bus error, and address error. These exceptions cause the instruction currently being executed to be aborted, and the exception processing to commence within two clock cycles. The Group 1 exceptions are trace and interrupt, as well as the privilege violations and illegal instructions. These exceptions allow the current instruction to execute to completion, but preempt the execution of the next instruction by forcing exception processing to occur (privilege violations and illegal instructions are detected when they are the next instruction to be executed). The Group 2 exceptions occur as part of the normal processing of instructions. The TRAP, TRAPV, CHK, and zero divide exceptions are in this group. For these exceptions, the normal execution of an instruction may lead to exception processing.

Group 0 exceptions have highest priority, while Group 2 exceptions have lowest priority. Within Group 0, reset has highest priority, followed by address error and then bus error. Within Group 1, trace has priority over external interrupts, which in turn takes priority over illegal instruction and privilege violation. Since only one instruction can be executed at a time, there is no priority relation within Group 2.

The priority relation between two exceptions determines which is taken, or taken first, if the conditions for both arise simultaneously. Therefore, if a bus error occurs during a TRAP instruction, the bus error takes precedence, and the TRAP instruction processing is aborted. In another example, if an interrupt request occurs during the execution of an instruction while the T-bit is asserted, the trace exception has priority, and is processed first. Before instruction processing resumes, however, the interrupt exception is also processed, and instruction processing commences finally in the interrupt handler routine. A summary of exception grouping and priority is given in Table 8.

Table 8 Exception Grouping and Priority

Group	Exception	Processing
0	Reset Address Error Bus Error	Exception processing begins within two clock cycles.
1	Trace Interrupt Illegal Privilege	Exception processing begins before the next instruction
2	TRAP, TRAPV CHK, Zero Divide	Exception processing is started by normal instruction execution

RECOGNITION TIMES OF EXCEPTIONS, HALT, AND BUS ARBITRATION

- END OF A CLOCK CYCLE
RESET
- END OF A BUS CYCLE
ADDRESS ERROR
BUS ERROR
HALT
BUS ARBITRATION
- END OF AN INSTRUCTION CYCLE
TRACE EXCEPTION
INTERRUPT EXCEPTIONS
ILLEGAL INSTRUCTION
UNIMPLEMENTED INSTRUCTION
PRIVILEGE VIOLATION
- WITHIN AN INSTRUCTION CYCLE
TRAP, TRAPV
CHK
ZERO DIVIDE

● **EXCEPTION PROCESSING DETAILED DISCUSSION**

Exceptions have a number of sources, and each exception has processing which is peculiar to it. The following paragraphs detail the sources of exceptions, how each arises, and how each is processed.

RESET

The reset input provides the highest exception level. The processing of the reset signal is designed for system initiation, and recovery from catastrophic failure. Any processing in progress at the time of the reset is aborted and cannot be recovered. The processor is forced into the supervisor state, and the trace state is forced off. The processor interrupt priority mask is set at level seven. The vector number is internally generated to reference the reset exception vector at location 0 in the supervisor program space. Because no assumptions can be made about the validity of register contents, in particular the supervisor stack pointer, neither the program counter nor the status register is saved. The address contained in the first two words of the reset exception vector is fetched as the initial supervisor stack pointer, and the address in the last two words of the reset exception vector is fetched as the initial program counter. Finally, instruction execution is started at the address in the program counter. The power-up/restart code should be pointed to by the initial program counter.

The RESET instruction does not cause loading of the reset vector, but does assert the reset line to reset external devices. This allows the software to reset the system to a known state and then continue processing with the next instruction.

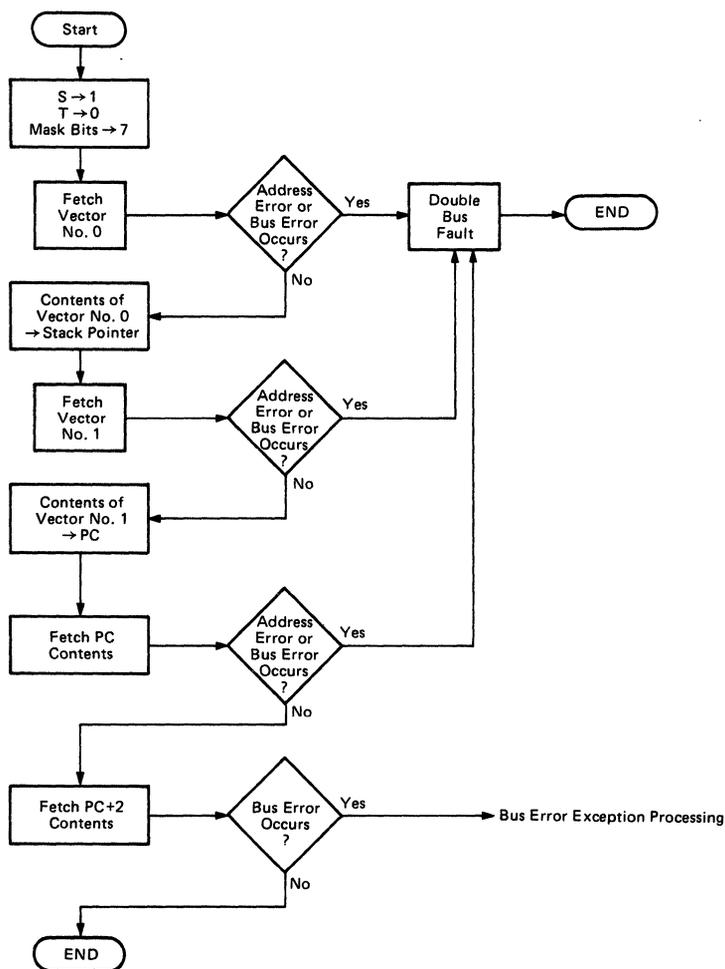


Figure 36 Reset Exception Processing

INTERRUPTS

Seven levels of interrupt priorities are provided. Devices may be chained externally within interrupt priority levels, allowing an unlimited number of peripheral devices to interrupt the processor. Interrupt priority levels are numbered from one to seven, with level seven being the highest priority. The status register contains a three-bit mask which indicates the current processor priority, and interrupts are inhibited for all priority levels less than or equal to the current processor priority.

An interrupt request is made to the processor by encoding the interrupt request level on the interrupt request lines; a zero indicates no interrupt request. Interrupt requests arriving at the processor do not force immediate exception processing,

but are made pending. Pending interrupts are detected between instruction executions. If the priority of the pending interrupt is lower than or equal to the current processor priority, execution continues with the next instruction and the interrupt exception processing is postponed. (The recognition of level seven is slightly different, as explained in a following paragraph.)

If the priority of the pending interrupt is greater than the current processor priority, the exception processing sequence is started. First a copy of the status register is saved, and the privilege state is set to supervisor, tracing is suppressed, and the processor priority level is set to the level of the interrupt being acknowledged. The processor fetches the vector number from the interrupting device, classifying the reference as an interrupt acknowledge and displaying the level number of

the interrupt being acknowledged on the address bus. If external logic requests an automatic vectoring, the processor internally generates a vector number which is determined by the interrupt level number. If external logic indicates a bus error, the interrupt is taken to be spurious, and the generated vector number references the spurious interrupt vector. The processor then proceeds with the usual exception processing, saving the program counter and status register on the supervisor stack. The saved value of the program counter is the address of the instruction which would have been executed had the interrupt not been present. The content of the interrupt vector whose vector number was previously obtained is fetched and loaded into the program counter, and normal instruction execution commences in the interrupt handling routine. A flow chart for the interrupt acknowledge sequence is given in Figure 37, a timing diagram is given in Figure 38, and the interrupt exception timing sequence is shown in Figure 39.

Table 9 Internal Interrupt Level

Level	I2	I1	I0	Interrupt
7	1	1	1	Non-Maskable Interrupt
6	1	1	0	
5	1	0	1	Maskable Interrupt
4	1	0	0	
3	0	1	1	
2	0	1	0	
1	0	0	1	No Interrupt
0	0	0	0	

(NOTE) The internal interrupt mask level (I2, I1, I0) are inverted to the logic level applied to the pins (IPL₂, IPL₁, IPL₀).

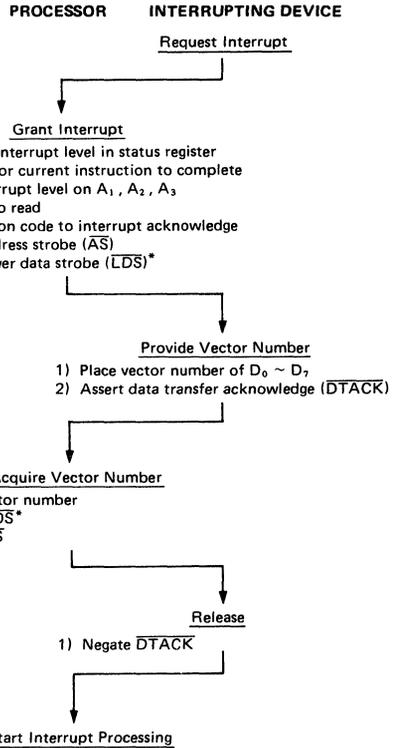
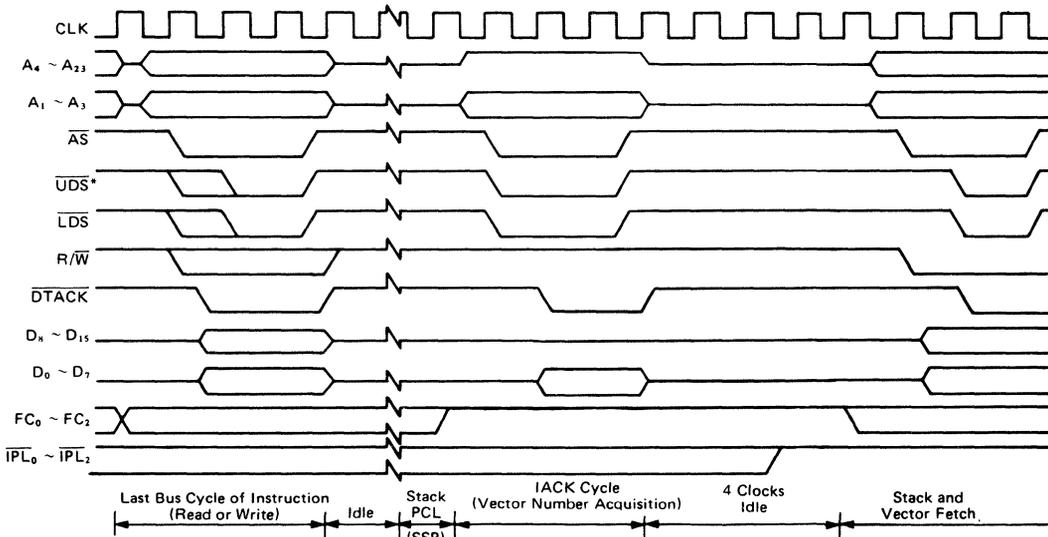


Figure 37 Interrupt Acknowledge Sequence Flow Chart



* Although a vector number is one byte, both data strobes are asserted due to the microcode used for exception processing. The processor does not recognize anything on data lines D₈ through D₁₅ at this time.

Figure 38 Interrupt Acknowledge Sequence Timing Diagram

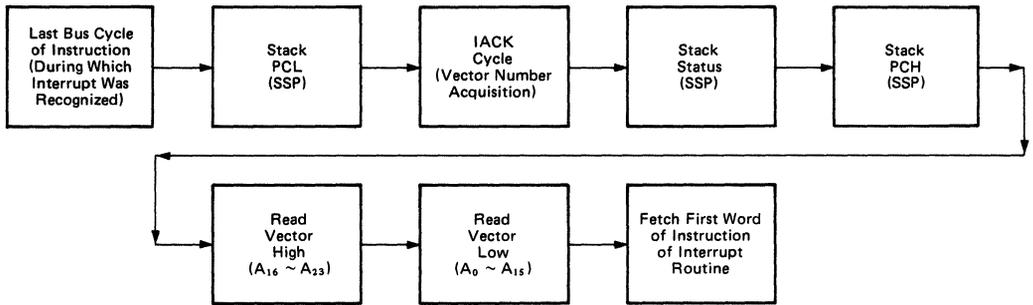


Figure 39 Interrupt Exception Timing Sequence

Priority level seven is a special case. Level seven interrupts cannot be inhibited by the interrupt priority mask, thus providing a “non-maskable interrupt” capability. An interrupt is generated each time the interrupt request level changes from some lower level to level seven. Note that a level seven interrupt may still be caused by the level comparison if the request level is a seven and the processor priority is set to a lower level by an instruction.

UNINITIALIZED INTERRUPT

An interrupting device asserts \overline{VPA} or provides an interrupt vector during an interrupt acknowledge cycle to the HD68000. If the vector register has not been initialized, the responding HMCS68000 Family peripheral will provide vector 15, the uninitialized interrupt vector. This provides a uniform way to recover from a programming error.

SPURIOUS INTERRUPT

If during the interrupt acknowledge cycle no device responds by asserting \overline{DTACK} or \overline{VPA} , the bus error line should be asserted to terminate the vector acquisition. The processor separates the processing of this error from bus error by fetching the spurious interrupt vector instead of the bus error vector. The processor then proceeds with the usual exception processing.

INSTRUCTION TRAPS

Traps are exceptions caused by instructions. They arise either from processor recognition of abnormal conditions during instruction execution, or from use of instructions whose normal behavior is trapping.

Some instructions are used specifically to generate traps. The TRAP instruction always forces an exception, and is useful for implementing system calls for user programs. The TRAPV and CHK instructions force an exception if the user program detects a runtime error, which may be an arithmetic overflow or a subscript out of bounds.

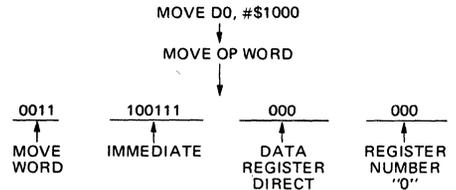
The signed divide (DIVS) and unsigned divide (DIVU) instructions will force an exception if a division operation is attempted with a divisor of zero.

ILLEGAL AND UNIMPLEMENTED INSTRUCTIONS

Illegal instruction is the term used to refer to any of the word bit patterns which are not the bit pattern of the first word of a legal instruction. During instruction execution, if such an instruction is fetched, an illegal instruction exception occurs.

Word patterns with bits 15 through 12 equaling 1010 or 1111 are distinguished as unimplemented instructions and separate exception vectors are given to these patterns to permit efficient emulation. This facility allows the operating system to detect program errors, or to emulate unimplemented instructions in software.

ILLEGAL INSTRUCTION EXAMPLE



PRIVILEGE VIOLATIONS

In order to provide system security, various instructions are privileged. An attempt to execute one of the privileged instructions while in the user state will cause an exception. The privileged instructions are:

- STOP
- RESET
- RTE
- MOVE to SR
- AND (word) Immediate to SR
- EOR (word) Immediate to SR
- OR (word) Immediate to SR
- MOVE USP

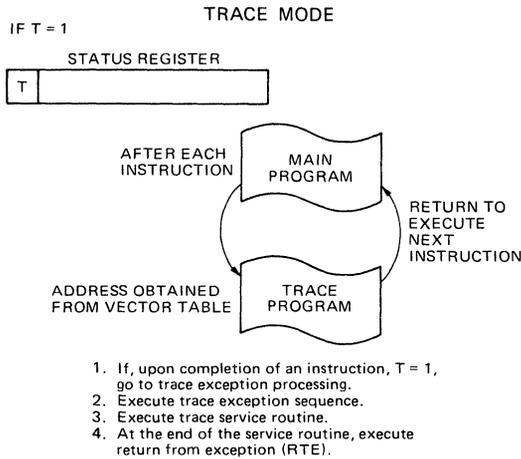
TRACING

To aid in program development, the HD68000 includes a facility to allow instruction by instruction tracing. In the trace state, after each instruction is executed an exceptions is forced, allowing a debugging program to monitor the execution of the program under test.

The trace facility uses the T-bit in the supervisor portion of the status register. If the T-bit is negated (off), tracing is disabled, and instruction execution proceeds from instruction to instruction as normal. If the T-bit is asserted (on) at the beginning of the execution of an instruction, a trace exception will be generated after the execution of that instruction is completed. If the instruction is not executed, either because an interrupt is taken, or the instruction is illegal or privileged, the trace exception does not occur. The trace exception also does not occur if the instruction is aborted by a reset, bus

error, or address error exception. If the instruction is indeed executed and an interrupt is pending on completion, the trace exception is processed before the interrupt exception. If, during the execution of the instruction, an exception is forced by that instruction, the forced exception is processed before the trace exception.

As an extreme illustration of the above rules, consider the arrival of an interrupt during the execution of a TRAP instruction while tracing is enabled. First the trap exception is processed, then the trace exception, and finally the interrupt exception. Instruction execution resumes in the interrupt handler routine.



BUS ERROR

Bus error exceptions occur when the external logic requests that a bus error be processed by an exception. The current bus cycle which the processor is making is then aborted. Whether the processor was doing instruction or exception processing, that processing is terminated, and the processor immediately begins exception processing.

Exception processing for bus error follows the usual sequence of steps. The status register is copied, the supervisor state is entered, and the trace state is turned off. The vector number is generated to refer to the bus error vector. Since the processor was not between instructions when the bus error exception request was made, the context of the processor is more detailed. To save more of this context, additional information is saved on the supervisor stack. The program counter and the copy of the status register are of course saved. The value saved for the program counter is advanced by some amount, two to ten bytes beyond the address of the first word of the instruction which made the reference causing the bus error. If the bus error occurred during the fetch of the next instruction, the saved program counter has a value in the vicinity of the current instruction, even if the current instruction is a branch, a jump, or a return instruction. Besides the usual information, the processor saves its internal copy of the first word of the instruction being processed, and the address which was being accessed by the aborted bus cycle. Specific information about the access is also saved: whether it was a read or a write, whether the processor was processing an instruction or not, and the classification displayed on the function code outputs when

the bus error occurred. The processor is processing an instruction if it is in the normal state or processing a Group 2 exception; the processor is not processing an instruction if it is processing a Group 0 or a Group 1 exception. Figure 40 illustrates how this information is organized on the supervisor stack. Although this information is not sufficient in general to effect full recovery from the bus error, it does allow software diagnosis. Finally, the processor commences instruction processing at the address contained in the vector. It is the responsibility of the error handler routine to clean up the stack and determine where to continue execution.

If a bus error occurs during the exception processing for a bus error, address error, or reset, the processor is halted, and all processing ceases. This simplifies the detection of catastrophic system failure, since the processor removes itself from the system rather than destroy all memory contents. Only the RESET pin can restart a halted processor.

ADDRESS ERROR

Address error exceptions occur when the processor attempts to access a word or a long word operand or an instruction at an odd address. The effect is much like an internally generated bus error, so that the bus cycle is aborted, and the processor ceases whatever processing it is currently doing and begins exception processing. After exception processing commences, the sequence is the same as that for bus error including the information that is stacked, except that the vector number refers to the address error vector instead. Likewise, if an address error occurs during the exception processing for a bus error, address error, or reset, the processor is halted. As shown in Figure 42, an address error will execute a short bus cycle followed by exception processing.

■ INTERFACE WITH HMCS6800 PERIPHERALS

Hitachi's extensive line of HMCS6800 peripherals are directly compatible with the HD68000. Some of these devices that are particularly useful are:

- HD6821 Peripheral Interface Adapter
- HD6840 Programmable Timer Module
- HD6843 Floppy Disk Controller
- HD6845S CRT Controller
- HD46508 Analog Data Acquisition Unit
- HD6850 Asynchronous Communication Interface Adapter
- HD6852 Synchronous Serial Data Adapter

To interface the synchronous HMCS6800 peripherals with the asynchronous HD68000, the processor modifies its bus cycle to meet the HMCS6800 cycle requirements whenever an HMCS6800 device address is detected. This is possible since both processors use memory mapped I/O. Figure 44 is a flow chart of the interface operation between the processor and HMCS6800 devices.

● DATA TRANSFER OPERATION

Three signal on the processor provide the HMCS6800 interface. They are: enable (E), valid memory address (VMA), and valid peripheral address (VPA). Enable corresponds to the E or ϕ_2 signal in existing HMCS6800 systems. The bus frequency is one tenth of the incoming HD68000 clock frequency. The timing of E allows 1 MHz peripherals to be used with an 8 MHz HD68000. Enable has a 60/40 duty cycle; that is, it is low for six input clocks and high for four input clocks. This duty cycle allows the processor to do successive VPA accesses on successive E pulses.

HMCS6800 cycle timing is given in Figure 45 and 46. At

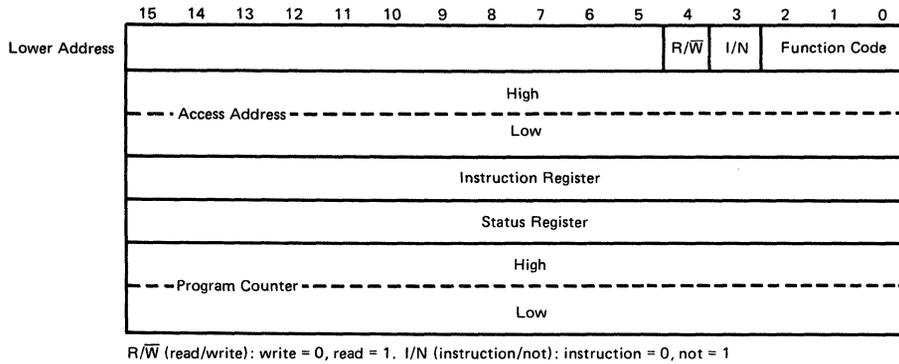


Figure 40 Supervisor Stack Order (Group 0)

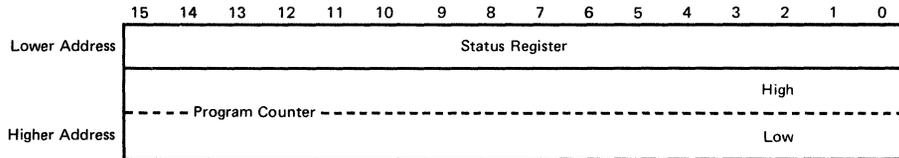


Figure 41 Supervisor Stack Order (Group 1, 2)

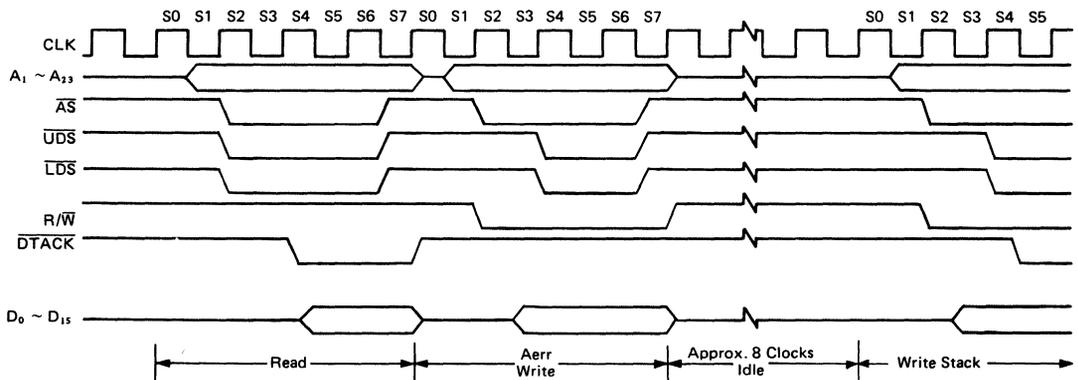


Figure 42 Address Error Timing

state zero (S0) in the cycle, the address bus is in the high-impedance state. A function code is asserted on the function code output lines. One-half clock later, in state 1 the address bus is released from the high-impedance state.

During state 2, the address strobe (\overline{AS}) is asserted to indicate that there is a valid address on the address bus. If the bus cycle is a read cycle, the upper and/or lower data strobes are also asserted in state 2. If the bus cycle is a write cycle,

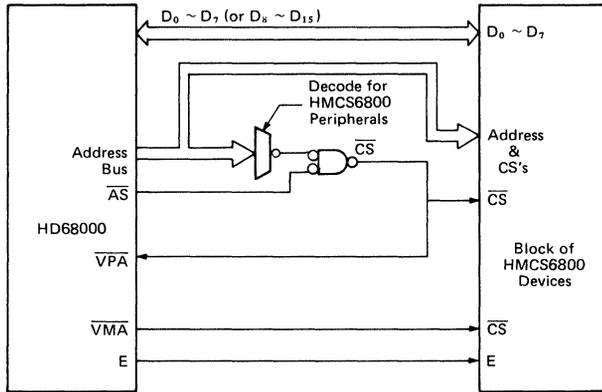


Figure 43 Connection of HMCS6800 Peripherals

the read/write (R/\bar{W}) signal is switched to low (write) during state 2. One half clock later, in state 3, the write data is placed on the data bus, and in state 4 the data strobes are issued to indicate valid data on the data bus. The processor now inserts wait states until it recognizes the assertion of \bar{VPA} .

The \bar{VPA} input signals the processor that the address on the bus is the address of an HMCS6800 device (or an area reserved for HMCS6800 devices) and that the bus should conform to the ϕ_2 transfer characteristics of the HMCS6800 bus. Valid peripheral address is derived by decoding the address bus, conditioned by address strobe. Chip select for the HMCS6800 peripherals should be derived by decoding the address bus conditioned by \bar{VMA} .

After the recognition of \bar{VPA} , the processor assures that the Enable (E) is low, by waiting if necessary, and subsequently asserts \bar{VMA} . Valid memory address is then used as part of the chip select equation of the peripheral. This ensures that the HMCS6800 peripherals are selected and deselected at the correct time. The peripheral now runs its cycle during the high portion of the E signal. Figures 45 and 46 depict the best and worst case HMCS6800 cycle timing. This cycle length is dependent strictly upon when \bar{VPA} is asserted in relationship to the E clock.

If we assume that external circuitry asserts \bar{VPA} as soon as possible after the assertion of \bar{AS} , then \bar{VPA} will be recognized as being asserted on the falling edge of $S4$. In this case, no "extra" wait cycles will be inserted prior to the recognition of \bar{VPA} asserted and only the wait cycles inserted to synchronize with the E clock will determine the total length of the cycle. In any case, the synchronization delay will be some integral number of clock cycles within the following two extremes:

1. Best Case - \bar{VPA} is recognized as being asserted on the falling edge three clock cycles before E rises for three clock cycles after E falls).
2. Worst Case - \bar{VPA} is recognized as being asserted on the falling edge two clock cycles before E rises (or four clock cycles after E falls).

During a read cycle, the processor latches the peripheral data in state 6. For all cycles, the processor negates the address and data strobes one half clock cycle later in state 7, and the Enable signal goes low at this time. Another half clock later, the address bus is put in the high-impedance state. During a write cycle, the data bus is put in the high-impedance state

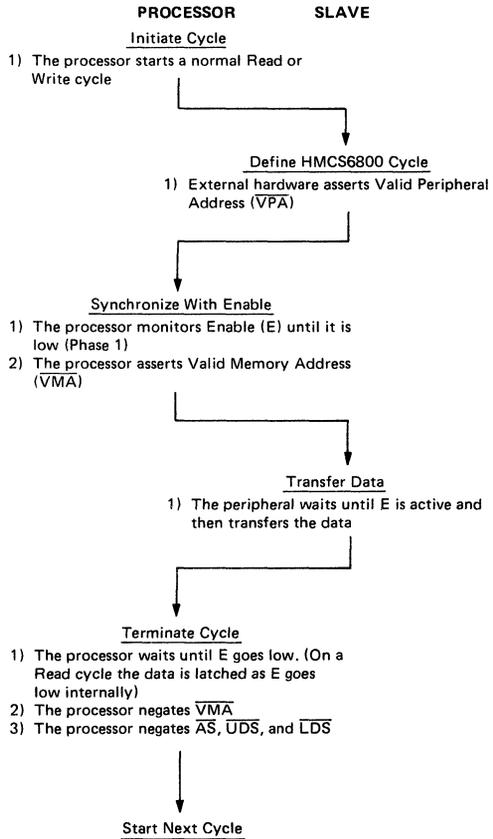
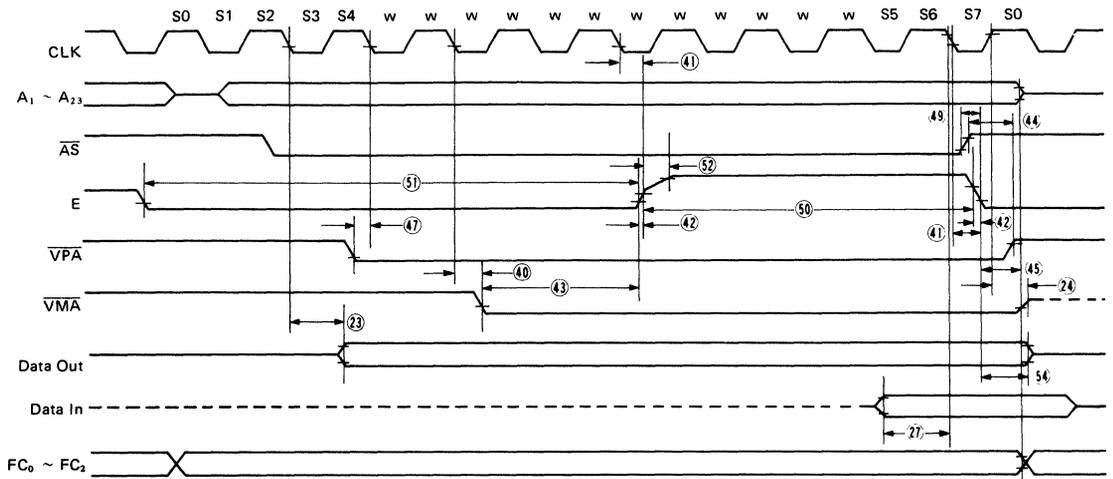


Figure 44 HMCS6800 Interface Flow Chart



(NOTE) This figure represents the best case HMCS6800 timing where \overline{VPA} falls before the third system clock cycle after the falling edge of E.

Figure 45 HMCS6800 Timing – Best Case

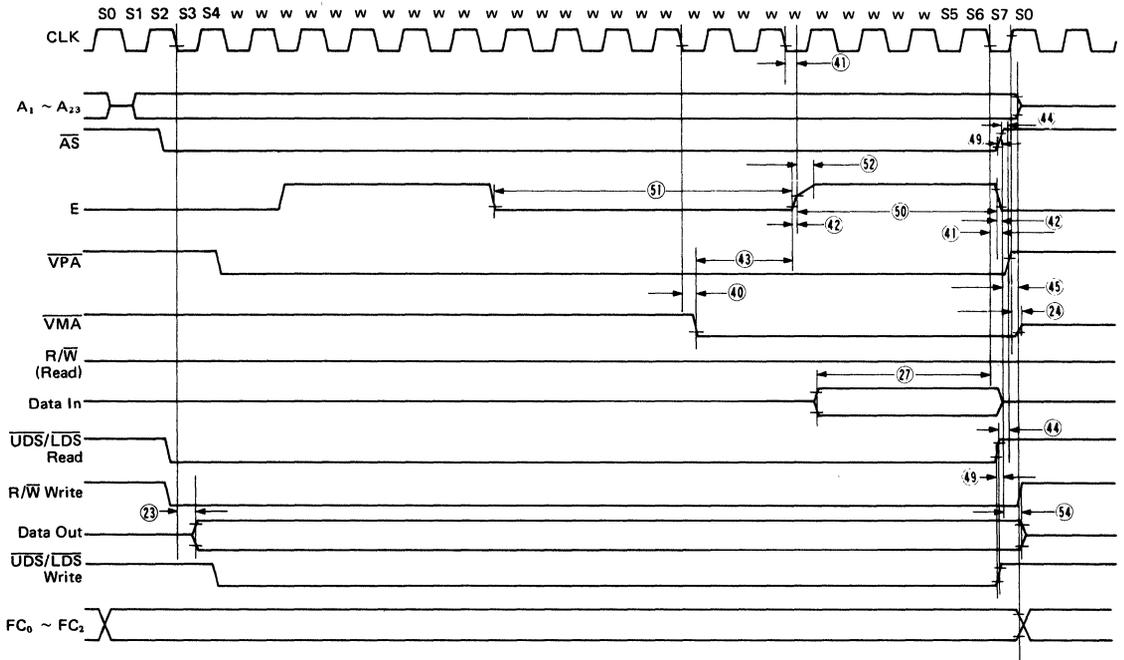


Figure 46 HMCS6800 Timing – Worst Case

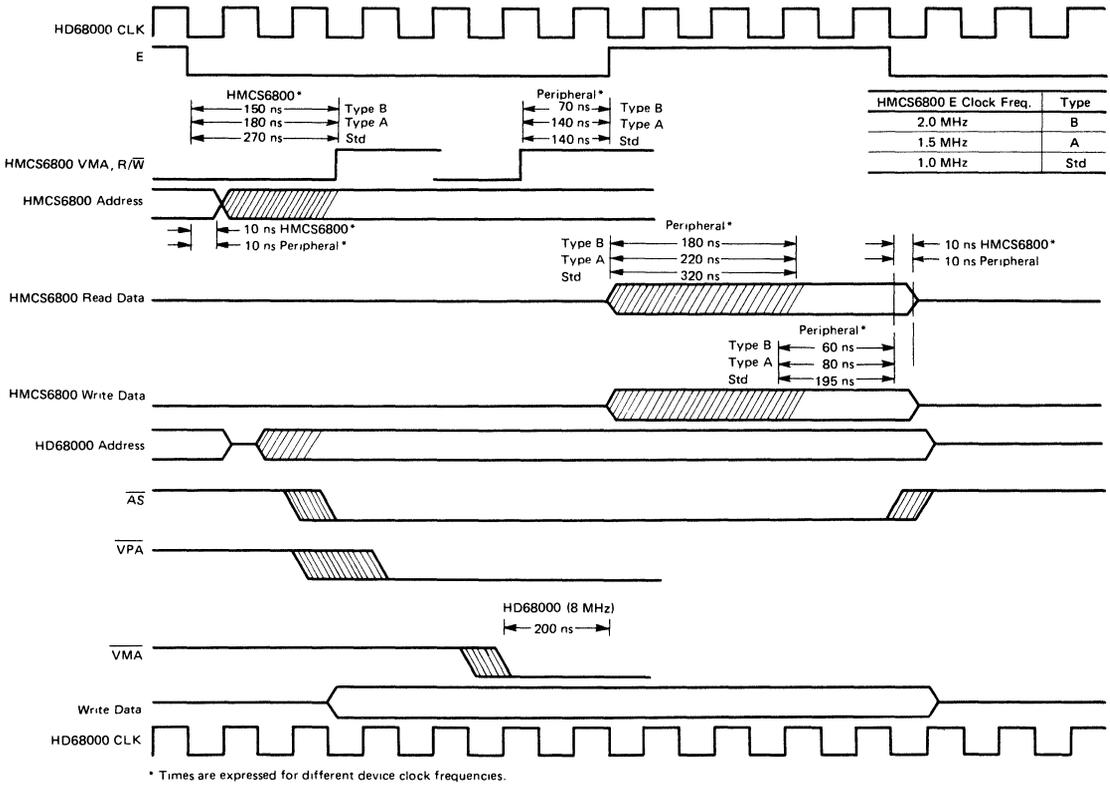


Figure 47 HD68000 to HMCS6800 Peripheral Timing Diagram

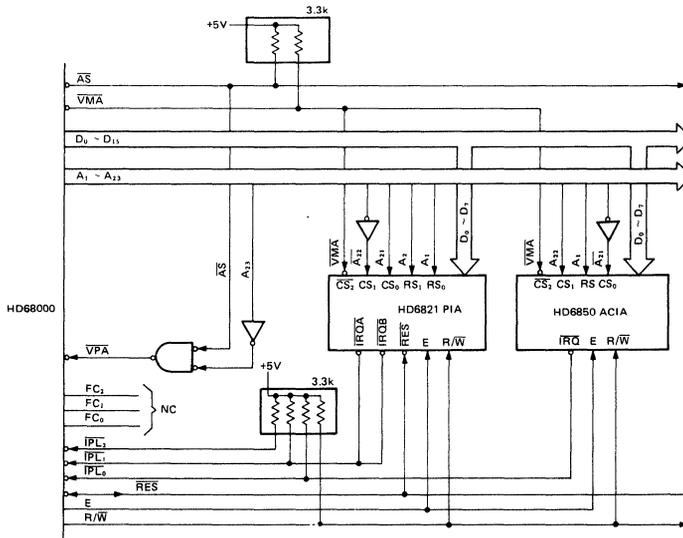


Figure 48 HMCS6800 Interface - Example 1

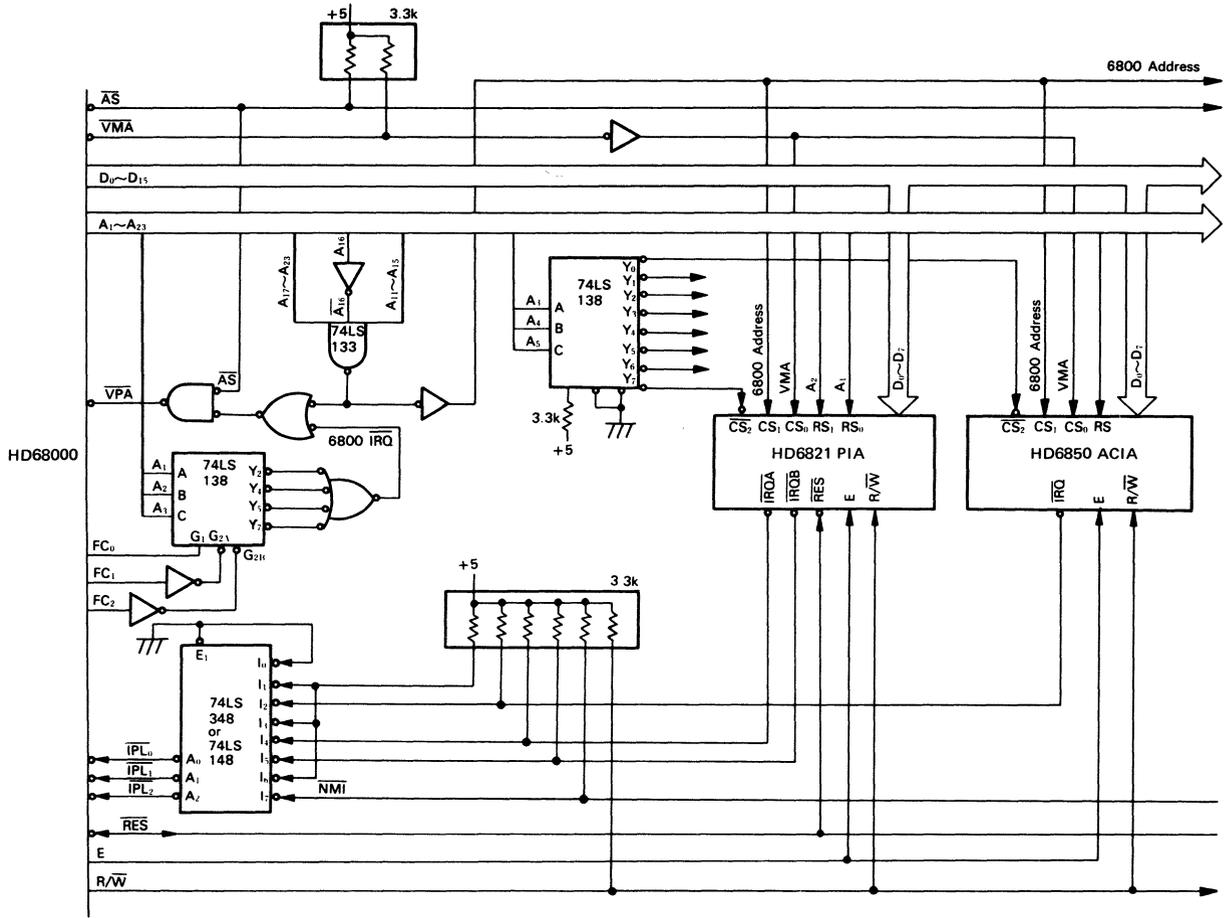


Figure 49 HMCS6800 Interface – Example 2

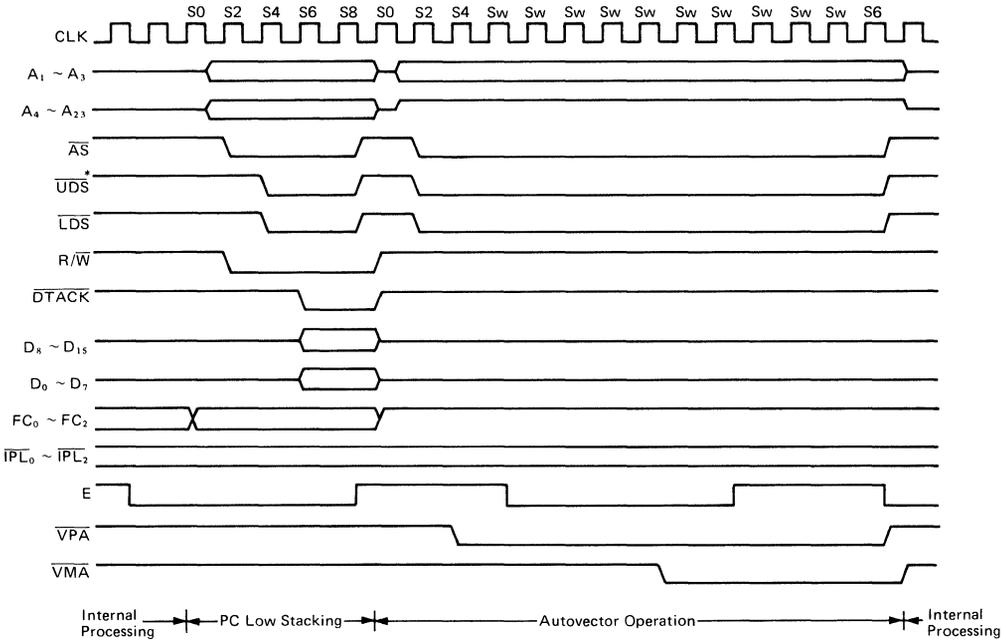
and the read/write signal is switched high. The peripheral logic must remove \overline{VPA} within one clock after address strobe is negated.

Figure 47 shows the timing required by HMCS6800 peripherals, the timing specified for HMCS6800, and the corresponding timing for the HD68000. Two example systems with HMCS6800 peripherals are shown in Figures 48 and 49. The system in Figure 48 reserves the upper eight megabytes of memory for HMCS6800 peripherals. The system in Figure 49 is more efficient with memory and easily expandable, but more complex.

\overline{DTACK} should not be asserted while \overline{VPA} is asserted. Notice that the HD68000 \overline{VMA} is active low, contrasted with the active high HMCS6800 VMA. This allows the processor to put its buses in the high-impedance state on DMA requests without inadvertently selecting peripherals.

● INTERRUPT OPERATION

During an interrupt acknowledge cycle while the processor is fetching the vector, if \overline{VPA} is asserted, the HD68000 will assert VMA and complete a normal HMCS6800 read cycle as shown in Figure 50. The processor will then use an internally



* Although a vector number is one byte, both data strobes are asserted due to the microcode used for exception processing. The processor does not recognize anything on data lines D₈ through D₁₅ at this time.

Figure 50 Autovector Operation Timing Diagram

generated vector that is a function of the interrupt being serviced. This process is known as autovectoring. The seven autovectors are vector numbers 25 through 31 (decimal).

This operates in the same fashion (but is not restricted to) the HMCS6800 interrupt sequence. The basic difference is that there are six normal interrupt vectors and one NMI type vector. As with both the HMCS6800 and the HD68000's normal vectored interrupt, the interrupt service routine can be located anywhere in the address space. This is due to the fact that while the vector numbers are fixed, the contents of the vector table entries are assigned by the user.

Since \overline{VMA} is asserted during autovectoring, the HMCS6800 peripheral address decoding should prevent unintended accesses.

■ DATA TYPES AND ADDRESSING MODES

Five basic data types are supported. These data types are:

- Bits

- BCD Digits (4-bits)
- Bytes (8-bits)
- Word (16-bits)
- Long Words (32-bits)

In addition, operations on other data types such as memory addresses, status word data, etc., are provided for in the instruction set.

The 14 addressing modes, shown in Table 10, includes six basic types:

- Register Direct
- Register Indirect
- Absolute
- Immediate
- Program Counter Relative
- Implied

Included in the register indirect addressing modes is the capability to do postincrementing, predecrementing, offsetting and indexing. Program counter relative mode can also be modified via indexing and offsetting.

Table 10 Addressing Modes

Mode	Generation
Register Direct Addressing Data Register Direct Address Register Direct	EA = Dn EA = An
Absolute Data Addressing Absolute Short Absolute Long	EA = (Next Word) EA = (Next Two Words)
Program Counter Relative Addressing Relative with Offset Relative with Index and Offset	EA = (PC) + d ₁₆ EA = (PC) + (Xn) + d _s
Register Indirect Addressing Register Indirect Postincrement Register Indirect Predecrement Register Indirect Register Indirect with Offset Indexed Register Indirect with Offset	EA = (An) EA = (AN), An ← An + N An ← An - N, EA = (An) EA = (An) + d ₁₆ EA = (An) + (Xn) + d _s
Immediate Data Addressing Immediate Quick Immediate	DATA = Next Word(s) Inherent Data
Implied Addressing Implied Register	EA = SR, USP, SP, PC

(NOTES)

- EA = Effective Address
- An = Address Register
- Dn = Data Register
- Xn = Address or Data Register used as Index Register
- SR = Status Register
- PC = Program Counter
- () = Contents of
- d_s = Eight-bit Offset (displacement)
- d₁₆ = Sixteen-bit Offset (displacement)
- N = 1 for Byte, 2 for Words and 4 for Long Words
- ← = Replaces

■ INSTRUCTION SET OVERVIEW

The HD68000 instruction set is shown in Table 11. Some additional instructions are variations, or subsets, of these and they appear in Table 12. Special emphasis has been given to the instruction set's support of structured high-level languages to facilitate ease of programming. Each instruction, with few exceptions, operates on bytes, words, and long words and most instructions can use any of the 14 addressing modes. Combining instruction types, data types, and addressing modes, over 1000 useful instructions are provided. These instructions include signed and unsigned multiply and divide, "quick" arithmetic operations, BCD arithmetic and expanded operations (through traps).

The following paragraphs contain an overview of the form and structure of the HD68000 instruction set. The instructions form a set of tools that include all the machine functions to perform the following operations:

- Data Movement
- Integer Arithmetic
- Logical
- Shift and Rotate
- Bit Manipulation
- Binary Coded Decimal
- Program Control
- System Control

The complete range of instruction capabilities combined with the flexible addressing modes described previously provide a very flexible base for program development.

Table 11 Instruction Set

Mnemonic	Description	Mnemonic	Description	Mnemonic	Description
ABCD	Add Decimal with Extend	EOR	Exclusive Or	PEA	Push Effective Address
ADD	Add	EXG	Exchange Registers	RESET	Reset External Devices
AND	Logical And	EXT	Sign Extend	ROL	Rotate Left without Extend
ASL	Arithmetic Shift Left	JMP	Jump	ROR	Rotate Right without Extend
ASR	Arithmetic Shift Right	JSP	Jump to Subroutine	ROXL	Rotate Left with Extend
BCC	Branch Conditionally	LEA	Load Effective Address	ROXR	Rotate Right with Extend
BCHG	Bit Test and Change	LINK	Link Stack	RTE	Return from Exception
BCLR	Bit Test and Clear	LSL	Logical Shift Left	RTR	Return and Restore
BRA	Branch Always	LSR	Logical Shift Right	RTS	Return from Subroutine
BSET	Bit Test and Set	MOVE	Move	SBCD	Subtract Decimal with Extend
BSR	Branch to Subroutine	MOVEM	Move Multiple Registers	S _{CC}	Set Conditional
BTST	Bit Test	MOVEP	Move Peripheral Data	STOP	Stop
CHK	Check Register Against Bounds	MULS	Signed Multiply	SUB	Subtract
CLR	Clear Operand	MULU	Unsigned Multiply	SWAP	Swap Data Register Halves
CMPI	Compare	NBCD	Negate Decimal with Extend	TAS	Test and Set Operand
DBCC	Test Condition, Decrement and Branch	NEG	Negate	TRAP	Trap
DIVS	Signed Divide	NOP	No Operation	TRAPV	Trap on Overflow
DIVU	Unsigned Divide	NOT	One's Complement	TST	Test
		OR	Logical Or	UNLK	Unlink

Table 12 Variations of Instruction Types

Instruction Type	Variation	Description	Instruction Type	Variation	Description
ADD	ADD	Add	MOVE	MOVE	Move
	ADDA	Add Address		MOVEA	Move Address
	ADDQ	Add Quick		MOVEQ	Move Quick
	ADDI	Add Immediate		MOVE from SR	Move from Status Register
	ADDX	Add with Extend		MOVE to SR	Move to Status Register
AND	AND	Logical And	MOVE to CCR	Move to Condition Codes	
	ANDI	And Immediate	MOVE USP	Move User Stack Pointer	
CMP	CMP	Compare	NEG	NEG	Negate
	COMPA	Compare Address		NEGX	Negate with Extend
	CMPM	Compare Memory	OR	OR	Logical Or
	CMPI	Compare Immediate		ORI	Or Immediate
EOR	EOR	Exclusive Or	SUB	SUB	Subtract
	EORI	Exclusive Or Immediate		SUBA	Subtract Address
				SUBI	Subtract Immediate
				SUBQ	Subtract Quick
				SUBX	Subtract with Extend

• ADDRESSING

Instructions for the HD68000 contain two kinds of information: the type of function to be performed, and the location of the operand(s) on which to perform that function. The methods used to locate (address) the operand(s) are explained in the following paragraphs.

Instructions specify an operand location in one of three ways:

- Register Specification – the number of the register is given in the register field of the instruction.
- Effective Address – use of the different effective address modes.
- Implicit Reference – the definition of certain instructions implies the use of specific registers.

• DATA MOVEMENT OPERATIONS

The basic method of data acquisition (transfer and storage) is provided by the move (MOVE) instruction. The move instruction and the effective addressing modes allow both address and data manipulation. Data move instructions allow byte, word, and long word operands to be transferred from memory to memory, memory to register, register to memory, and register to register. Address move instructions allow word and long word operand transfers and ensure that only legal address manipulations are executed. In addition to the general move instruction there are several special data movement instructions: move multiple registers (MOVEM), move peripheral data (MOVEP), exchange registers (EXG), load effective address (LEA), push effective address (PEA), link stack (LINK), unlink stack (UNLK), and move quick (MOVEQ). Table 13 is a summary of the data movement operations.

• INTEGER ARITHMETIC OPERATIONS

The arithmetic operations include the four basic operations of add (ADD), subtract (SUB), multiply (MUL), and divide (DIV) as well as arithmetic compare (CMP), clear (CLR), and negate (NEG). The add and subtract instructions are available for both address and data operations, with data operations accepting all operand sizes. Address operations are limited to legal address size operands (16 or 32 bits). Data, address, and memory compare operations are also available. The clear

and negate instructions may be used on all sizes of data operands.

The multiply and divide operations are available for signed and unsigned operands using word multiply to produce a long word product, and a long word dividend with word divisor to produce a word quotient with a word remainder.

Multiprecision and mixed size arithmetic can be accomplished using a set of extended instructions. These instructions are: add extended (ADDX), subtract extended (SUBX), sign extend (EXT), and negate binary with extend (NEGX).

A test operand (TST) instruction that will set the condition codes as a result of a compare of the operand with zero is also available. Test and set (TAS) is a synchronization instruction useful in multiprocessor systems. Table 14 is a summary of the integer arithmetic operations.

Table 13 Data Movement Operations

Instruction	Operand Size	Operation
EXG	32	Rx ↔ Ry
LEA	32	EA → An
LINK	–	(An → SP@- ; SP → An ; SP + d → SP
MOVE	8, 16, 32	(EA)s → EAd
MOVEM	16, 32	(EA) → An, Dn An, Dn → EA
MOVEP	16, 32	(EA) → Dn Dn → EA
MOVEQ	8	#xxx → Dn
PEA	32	EA → SP@-
SWAP	32	Dn[31:16] ↔ Dn[15:0]
UNLK	–	(An → Sp ; SP@+ → An

(NOTES)

- s = source
- d = destination
- [] = bit numbers

- @ - = indirect with predecrement
- @ + = indirect with postdecrement

Table 14 Integer Arithmetic Operations

Instruction	Operand Size	Operation
ADD	8, 16, 32	$D_n + (EA) \rightarrow D_n$ $(EA) + D_n \rightarrow EA$
	16, 32	$(EA) + \#xxx \rightarrow EA$ $AN + (EA) \rightarrow An$
ADDX	8, 16, 32 16, 32	$D_x + D_y + X \rightarrow D_x$ $A_x@ - +A_y@ - + X \rightarrow A_x@$
CLR	8, 16, 32	$0 \rightarrow EA$
CMP	8, 16, 32	$D_n - (EA)$ $(EA) - \#xxx$ $A_x@+ - A_y@+$
	16, 32	$An - (EA)$
DIVS	$32 \div 16$	$D_n/(EA) \rightarrow D_n$
DIVU	$32 \div 16$	$D_n/(EA) \rightarrow D_n$
EXT	8 \rightarrow 16	$(D_n)_8 \rightarrow D_{n16}$
	16 \rightarrow 32	$(D_n)_{16} \rightarrow D_{n32}$
MULS	$16*16 \rightarrow 32$	$D_n*(EA) \rightarrow D_n$
MULU	$16*16 \rightarrow 32$	$D_n*(EA) \rightarrow D_n$
NEG	8, 16, 32	$0 - (EA) \rightarrow EA$
NEGX	8, 16, 32	$0 - (EA) - X - EA$
SUB	8, 16, 32	$D_n - (EA) \rightarrow D_n$ $(EA) - D_n \rightarrow EA$
	16, 32	$(EA) - \#xxx \rightarrow EA$ $An - (EA) \rightarrow An$
SUBX	8, 16, 32	$D_x - D_y - X \rightarrow D_x$ $A_x@ - - A_y@ - - X \rightarrow A_x@$
TAS	8	$(EA) - 0, 1 \rightarrow EA[7]$
TST	8, 16, 32	$(EA) - 0$

(NOTE) [] = bit number

• INSTRUCTION FORMAT

Instructions are from one to five words in length, as shown in Figure 51. The length of the instruction and the operation to be performed is specified by the first word of the instruction which is called the operation word. The remaining words further specify the operands. These words are either immediate operands or extensions to the effective address mode specified in the operation word.

• PROGRAM/DATA REFERENCES

The HD68000 separates memory references into two classes: program references, and data references. Program references, as the name implies, are references to that section of memory that contains the program being executed. Data references refer to that section of memory that contains data. Operand reads are from the data space except in the case of the program counter relative addressing mode. All operand writes are to the data space.

• REGISTER SPECIFICATION

The register field within an instruction specifies the register to be used. Other fields within the instruction specify whether the register selected is an address or data register and how the register is to be used.

• EFFECTIVE ADDRESS

Most instructions specify the location of an operand by using the effective address field in the operation word. For example, Figure 52 shows the general format of the single effective address instruction operation word. The effective address is composed of two 3-bit fields: the mode field, and the register field. The value in the mode field selects the different address modes. The register field contains the number of a register.

The effective address field may require additional information to fully specify the operand. This additional information, called the effective address extension, is contained in the following word or words and is considered part of the instruction, as shown in Figure 51. The effective address modes are grouped into three categories: register direct, memory addressing, and special.

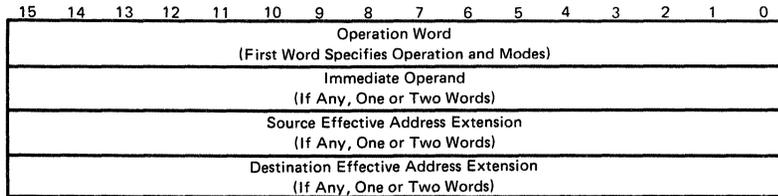


Figure 51 Instruction Format

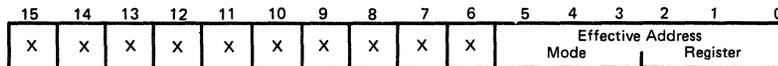


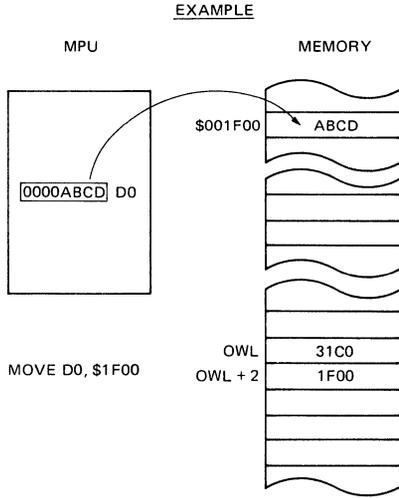
Figure 52 Single-Effective-Address Instruction Operation Word General Format

REGISTER DIRECT MODES

These effective addressing modes specify that the operand is in one of the 16 multifunction registers.

Data Register Direct

The operand is in the data register specified by the effective address register field.

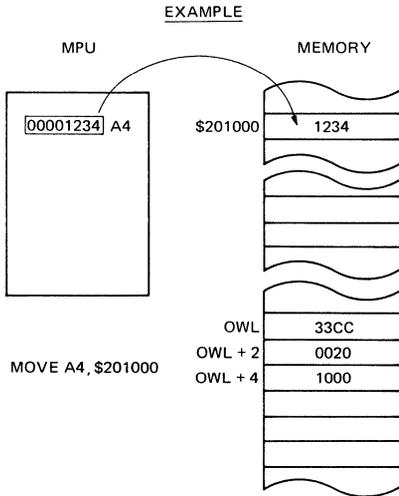


COMMENTS

- EA = Dn
 - Machine Level Coding
MOVE D0, \$1F00
-

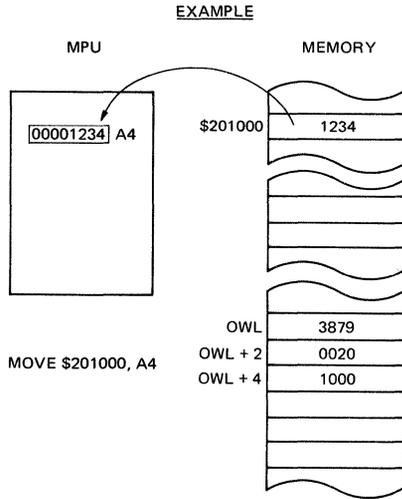
Address Register Direct

The operand is in the address register specified by the effective address register field.



COMMENTS

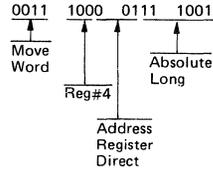
- EA = An
 - Machine Level Coding
MOVE A4, \$201000
-



COMMENTS

- EA = An
- Address Register Sign Extended
- Machine Level Coding

MOVE \$201000, A4

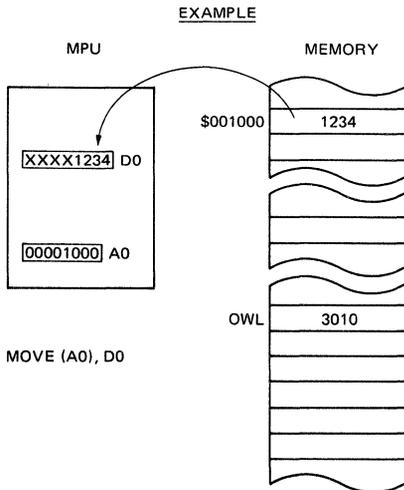


MEMORY ADDRESS MODES

These effective addressing modes specify that the operand is in memory and provide the specific address of the operand.

Address Register Indirect

The address of the operand is in the address register specified by the register field. The reference is classified as a data reference with the exception of the jump and jump to subroutine instructions.

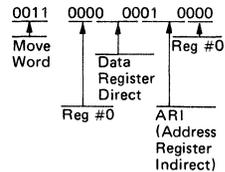


COMMENTS

- EA = (An)

- Machine Level Coding

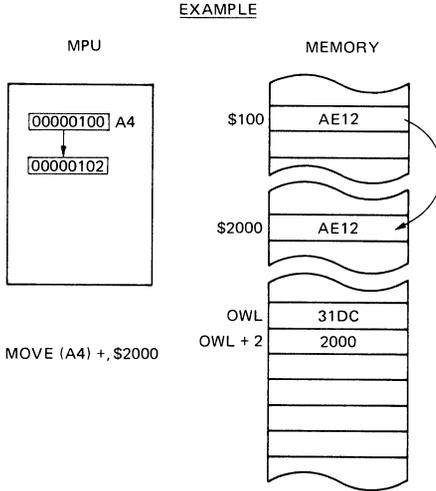
MOVE (A0), D0



Address Register Indirect With Postincrement

The address of the operand is in the address register specified by the register field. After the operand address is used, it is incremented by one, two, or four depending upon whether the size of the operand is byte, word, or long word. If the

address register is the stack pointer and the operand size is byte, the address is incremented by two rather than one to keep the stack pointer on a word boundary. The reference is classified as a data reference.

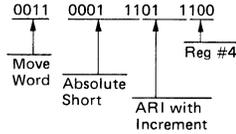


COMMENTS

- EA = (An); An + M → An
Where An → Address Register
M → 1, 2, or 4
(Depending Whether Byte, Word, or Long Word)

• Machine Level Coding

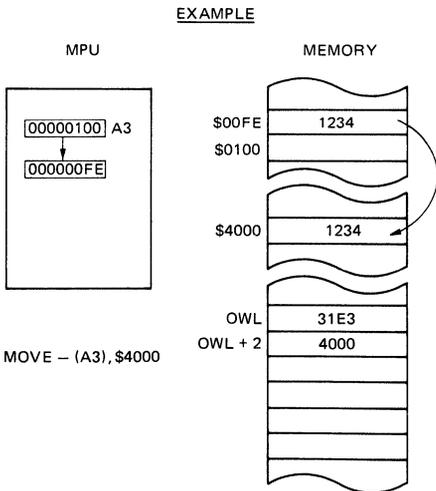
MOVE (A4) +, \$2000



Address Register Indirect With Predecrement

The address of the operand is in the address register specified by the register field. Before the operand address is used, it is decremented by one, two, or four depending upon whether the operand size is byte, word, or long word. If the address

register is the stack pointer and the operand size is byte, the address is decremented by two rather than one to keep the stack pointer on a word boundary. The reference is classified as a data reference.

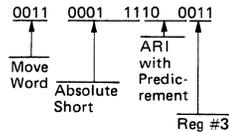


COMMENTS

- An - M → An; EA = (An)
Where An → Address Register
M → 1, 2, or 4
(Depending Whether Byte, Word, or Long Word)

• Machine Level Coding

MOVE - (A3), \$4000

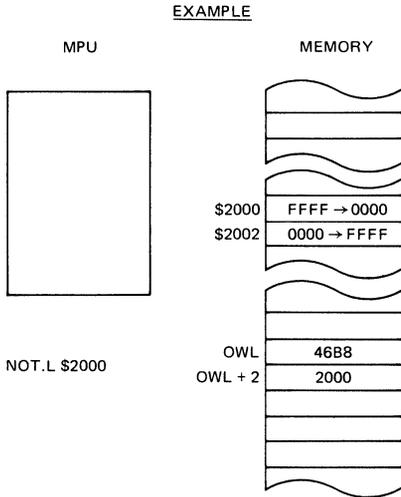


SPECIAL ADDRESS MODE

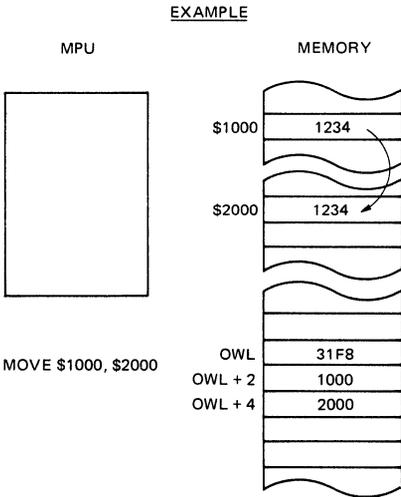
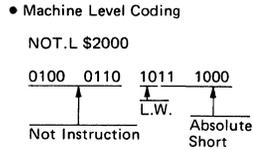
The special address modes use the effective address register field to specify the special addressing mode instead of a register number.

Absolute Short Address

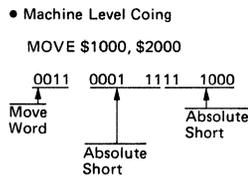
This address mode requires one word of extension. The address of the operand is the extension word. The 16-bit address is sign extended before it is used. The reference is classified as a data reference with the exception of the jump and jump to subroutine instructions.



- COMMENTS**
- EA = (Next Word)
 - 16-Bit Word is Sign Extended



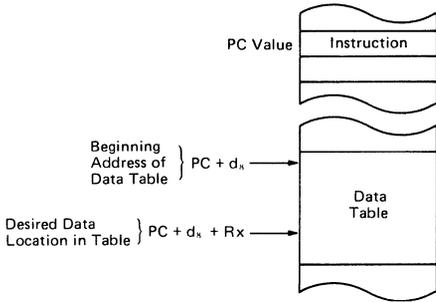
- COMMENTS**
- EA = (Next Word)
 - 16-Bit Word is Sign Extended



Program Counter With Index

This address mode requires one word of extension. This address is the sum of the address in the program counter, the sign-extended displacement integer in the lower eight bits of the extension word, and the contents of the index register. The value in the program counter is the address of the extension word. This reference is classified as a program reference.

$$EA = (PC) + (Rx) + d_s$$

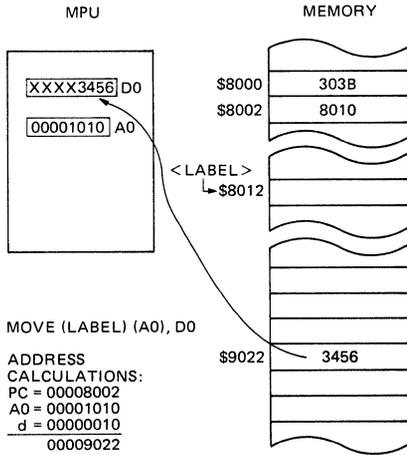


(NOTE)

Extension Word															
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
D/A	Register			W/L	0	0	0	Displacement Integer							

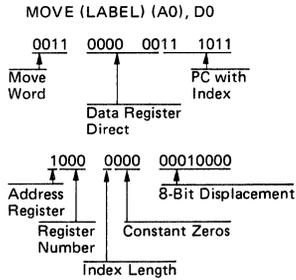
- D/A : Data Register = 0, Address Register = 1
- Register : Index Register Number
- W/L : Sign-extended, low order Word integer in Index Register = 0
- Long Word in Index Register = 1

EXAMPLE



COMMENTS

- EA = (PC) + (Rx) + d_s
- Where
 PC → Current Program Counter
 Rx → Designated Index Register (Either Data or Address Register)
 d_s → 8-Bit Displacement
- Rx and d_s are Sign Extended
- Rx may be Word or Long Word
- Long Word is Designated with Rx.L
- Machine Level Coding



Immediate Data

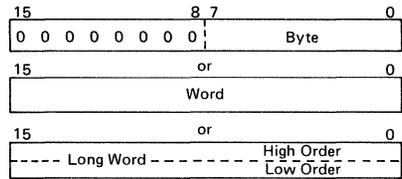
This address mode requires either one or two words of extension depending on the size of the operation.

Byte operation – operand is low order byte of extension word

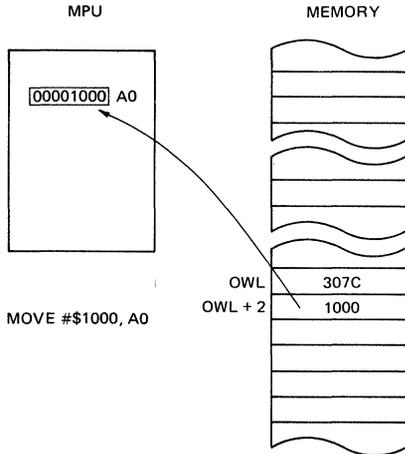
Word operation – operand is extension word

Long word operation – operand is in the two extension words, high-order 16 bits are in the first extension word, low-order 16 bits are in the second extension word.

Extension Word



EXAMPLE

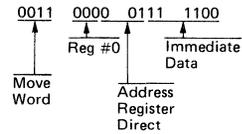


COMMENTS

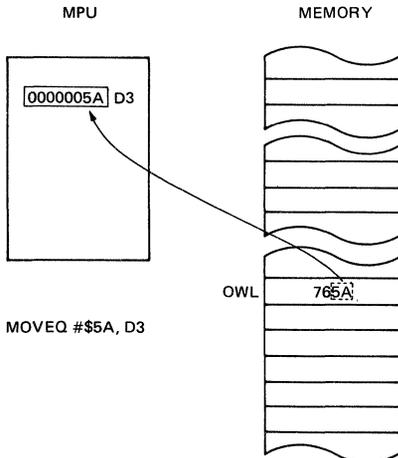
- Data = Next Word(s)
- Data is Sign Extended for Address Register but not Data Register

• Machine Level Coding

MOVE #\$1000, A0



EXAMPLE

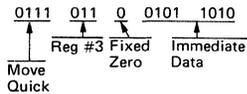


COMMENTS

- Inherent Data
- Data is Sign Extended to Long Word
- Destination must be a Data Register

• Machine Level Coding

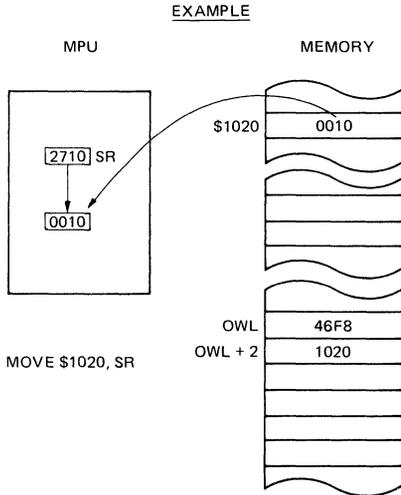
MOVEQ #\$5A, D3



Condition Codes or Status Register

A selected set of instructions may reference the status register by means of the effective address field. These are:

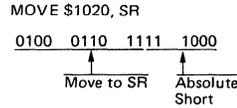
- ANDI to CCR
- ANDI to SR
- EORI to CCR
- EORI to SR
- ORI to CCR
- ORI to SR
- MOVE to CCR
- MOVE to SR
- MOVE from SR



COMMENTS

- EA = (Next Word)
- Note: This Example is a Privileged Instruction

• Machine Level Coding



• **EFFECTIVE ADDRESS ENCODING SUMMARY**

Table 15 is a summary of the effective addressing modes discussed in the previous paragraphs.

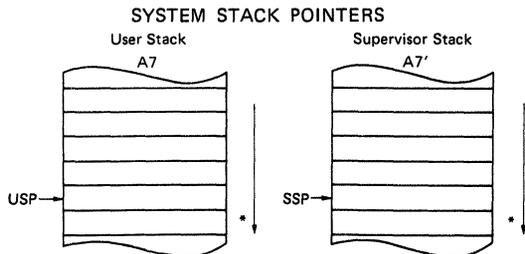
Table 15 Effective Address Encoding Summary

Addressing Mode	Mode	Register
Data Register Direct	000	register number
Address Register Direct	001	register number
Address Register Indirect	010	register number
Address Register Indirect with Postincrement	011	register number
Address Register Indirect with Predecrement	100	register number
Address Register Indirect with Displacement	101	register number
Address Register Indirect with Index	110	register number
Absolute Short	111	000
Absolute Long	111	001
Program Counter with Displacement	111	010
Program Counter with Index	111	011
Immediate	111	100

stack pointer (SSP), the user stack pointer (USP), or the status register (SR).

SYSTEM STACK

The system stack is used implicitly by many instructions; user stacks and queues may be created and maintained through the addressing modes. Address register seven (A7) is the system stack pointer (SP). The system stack pointer is either the supervisor stack pointer (SSP) or the user stack pointer (USP), depending on the state of the S-bit in the status register. If the S-bit indicates supervisor state, SSP is the active system stack pointer, and the USP cannot be referenced as an address register. If the S-bit indicates user state, the USP is the active system stack pointer, and the SSP cannot be referenced. Each system stack fills from high memory to low memory.



- Accessed when S = 0
- PC is Stacked on Subroutine Calls in User State

- Accessed when S = 1
- PC is Stacked on Subroutine Calls in Supervisor State
- Used for Exception Processing

* Increasing Addresses

• **IMPLICIT REFERENCE**

Some instructions make implicit reference to the program counter (PC), the system stack pointer (SP), the supervisor

The address mode SP @- creates a new item on the active system stack, and the address mode SP @+ deletes an item from the active system stack.

The program counter is saved on the active system stack on subroutine calls, and restored from the active system stack on returns. On the other hand, both the program counter and the status register are saved on the supervisor stack during the processing of traps and interrupts. Thus, the correct execution of the supervisor state code is not dependent on the behavior of user code and user programs may use the user stack pointer arbitrarily.

In order to keep data on the system stack aligned properly, data entry on the stack is restricted so that data is always put in the stack on a word boundary. Thus byte data is pushed on or pulled from the system stack in the high order half of the word; the lower half is unchanged.

USER STACKS

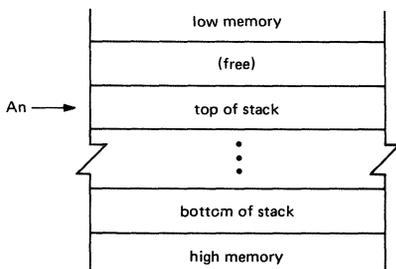
User stacks can be implemented and manipulated by employing the address register indirect with postincrement and predecrement addressing modes. Using an address register (on of A0 through A6), the user may implement stacks which are filled either from high memory to low memory, or vice versa. The important things to remember are:

- using predecrement, the register is decremented before its contents are used as the pointer into the stack,
- using postincrement, the register is incremented after its contents are used as the pointer into the stack,
- byte data must be put on the stack in pairs when mixed with word or long data so that the stack will not get misaligned when the data is retrieved. Word and long accesses must be on word boundary (even) addresses.

Stack growth from high to low memory is implemented with

- An@- to push data on the stack,
- An@+ to pull data from the stack.

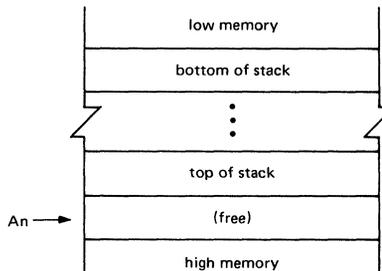
After either a push or a pull operation, register An points to the last (top) item on the stack. This is illustrated as:



Stack growth from low to high memory is implemented with

- An@+ to push data on the stack,
- An@- to pull data from the stack.

After either a push or a pull operation, register An points to the next available space on the stack. This is illustrated as:



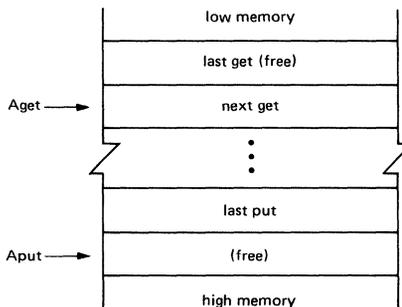
QUEUES

User queues can be implemented and manipulated with the address register indirect with postincrement or predecrement addressing modes. Using a pair of address registers (two of A0 through A6), the user may implement queues which are filled either from high memory to low memory, or vice versa. Because queues are pushed from one end and pulled from the other, two registers are used: the put and get pointers.

Queue growth from low to high memory is implemented with

- Aput@+ to put data into the queue,
- Aget@+ to get data from the queue.

After a put operation, the put address register points to the next available space in the queue and the unchanged get address register points to the next item to remove from the queue. After a get operation, the get address register points to the next item to remove from the queue and the unchanged put address register points to the next available space in the queue. This is illustrated as:

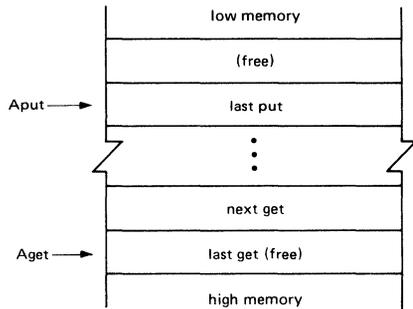


If the queue is to be implemented as a circular buffer, the address register should be checked and, if necessary, adjusted before the put or get operation is performed. The address register is adjusted by subtracting the buffer length (in bytes).

Queue growth from high to low memory is implemented with

- Aput@- to put data into the queue,
- Aget@- to get data from the queue.

After a put operation, the put address register points to the last item put in the queue, and the unchanged get address register points to the last item removed from the queue. After a get operation, the get address register points to the last item removed from the queue and the unchanged put address register points to the last item put in the queue. This is illustrated as:



If the queue is to be implemented as a circular buffer, the get or put operation should be performed first, and then the address register should be checked and, if necessary, adjusted. The address register is adjusted by adding the buffer length (in bytes).

● LOGICAL OPERATIONS

Logical operation instructions AND, OR, EOR, and NOT are available for all sizes of integer data operands. A similar set of immediate instructions (ANDI, ORI, and EORI) provide these logical operations with all sizes of immediate data. Table 16 is a summary of the logical operations.

Table 16 Logical Operations

Instruction	Operand Size	Operation
AND	8, 16, 32	$D_n \wedge (EA) \rightarrow D_n$ $(EA) \wedge D_n \rightarrow EA$ $(EA) \wedge \#xxx \rightarrow EA$
OR	8, 16, 32	$D_n \vee (EA) \rightarrow D_n$ $(EA) \vee D_n \rightarrow EA$ $(EA) \vee \#xxx \rightarrow EA$
EOR	8, 16, 32	$(EA) \oplus D_y \rightarrow EA$ $(EA) \oplus \#xxx \rightarrow EA$
NOT	8, 16, 32	$\sim (EA) \rightarrow EA$

[NOTE] \sim = invert

● SHIFT AND ROTATE OPERATIONS

Shift operations in both directions are provided by the arithmetic instructions ASR and ASL and logical shift instructions LSR and LSL. The rotate instructions (with and without extend) available are ROXR, ROXL, ROR, and ROL. All shift and rotate operations can be performed in either registers or memory. Register shifts and rotates support all operand sizes and allow a shift count specified in the instruction of one to eight bits, or 0 to 63 specified in a data register.

Memory shifts and rotates are for word operands only and allow only single-bit shifts or rotates. Table 17 is a summary of the shift and rotate operations.

Table 17 Shift and Rotate Operations

Instruction	Operand Size	Operation
ASL	8, 16, 32	
ASR	8, 16, 32	
LSL	8, 16, 32	
LSR	8, 16, 32	
ROL	8, 16, 32	
ROR	8, 16, 32	
ROXL	8, 16, 32	
ROXR	8, 16, 32	

● BIT MANIPULATION OPERATIONS

Bit manipulation operations are accomplished using the following instructions: bit test (BTST), bit test and set (BSET), bit test and clear (BCLR), and bit test and change (BCHG). Table 18 is a summary of the bit manipulation operations. (Bit 2 of the status register is Z.)

Table 18 Bit Manipulation Operations

Instruction	Operand Size	Operation
BTST	8, 32	\sim bit of (EA) \rightarrow Z
BSET	8, 32	\sim bit of (EA) \rightarrow Z; 1 \rightarrow bit of EA
BCLR	8, 32	\sim bit of (EA) \rightarrow Z; 0 \rightarrow bit of EA
BCHG	8, 32	\sim bit of (EA) \rightarrow Z; \sim bit of (EA) \rightarrow bit of EA

(Note) \sim = invert

● BINARY CODED DECIMAL OPERATIONS

Multiprecision arithmetic operations on binary coded decimal numbers are accomplished using the following instructions: add decimal with extend (ABCD), subtract decimal with extend (SBCD), and negate decimal with extend (NBCD). Table 19 is a summary of the binary coded decimal operations.

Table 19 Binary Coded Decimal Operations

Instruction	Operand Size	Operation
ABCD	8	$Dx_{10} + Dy_{10} + X \rightarrow Dx$ $Ax@_{-10} + Ay@_{-10} + X \rightarrow Ax@$
SBCD	8	$Dx_{10} - Dy_{10} - X \rightarrow Dx$ $Ax@_{-10} - Ay@_{-10} - X \rightarrow Ax@$
NBCD	8	$0 - (EA)_{10} - X \rightarrow EA$

● PROGRAM CONTROL OPERATIONS

Program control operations are accomplished using a series of conditional and unconditional branch instructions and return instructions. These instructions are summarized in Table 20.

The conditional instructions provide setting and branching for the following conditions:

- CC – carry clear
- CS – carry set
- EQ – equal
- F – never true
- GE – greater or equal
- GT – greater than
- HI – high
- LE – less or equal
- LS – low or same
- LT – less than
- MI – minus
- NE – not equal
- PL – plus
- T – always true
- VC – no overflow
- VS – overflow

Table 20 Program Control Operations

Instruction	Operation
Conditional	
BCC	Branch conditionally (14 conditions) 8- and 16-bit displacement
DBCC	Test condition, decrement, and branch 16-bit displacement
SCC	Set byte conditionally (16 conditions)
Unconditional	
BRA	Branch always 8- and 16-bit displacement
BSR	Branch to subroutine 8- and 16-bit displacement
JMP	Jump
JSR	Jump to subroutine
Returns	
RTR	Return and restore condition codes
RTS	Return from subroutine

● SYSTEM CONTROL OPERATIONS

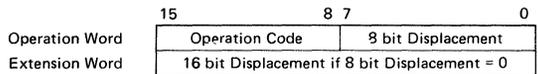
System control operations are accomplished by using privileged instructions, trap generating instructions, and instructions that use or modify the status register. These instructions are summarized in Table 21.

Table 21 System Control Operations

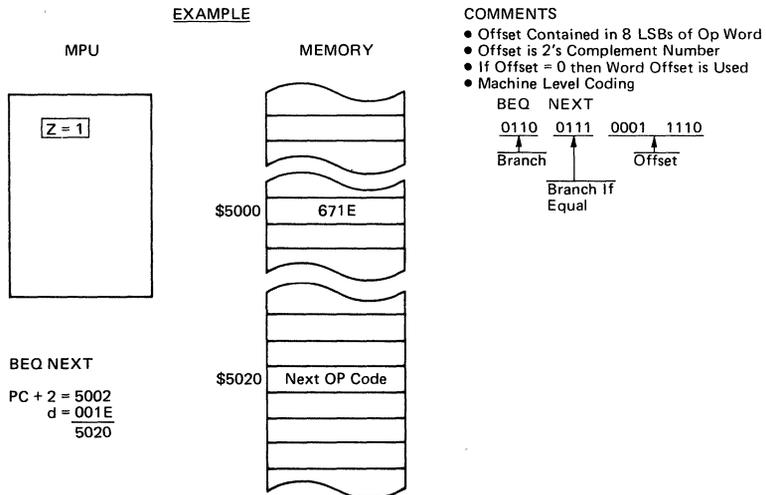
Instruction	Operation
Privileged	
RESET	Reset external devices
RTE	Return from exception
STOP	Stop program execution
ORI to SR	Logical OR to status register
MOVE USP	Move user stack pointer
ANDI to SR	Logical AND to status register
EORI to SR	Logical EOR to status register
MOVE EA to SR	Load new status register
Trap Generating	
TRAP	Trap
TRAPV	Trap on overflow
CHK	Check register against bounds
Status Register	
ANDI to CCR	Logical AND to condition codes
EORI to CCR	Logical EOR to condition codes
MOVE EA to CCR	Load new condition codes
ORI to CCR	Logical OR to condition codes
MOVE SR to EA	Store status register

● BRANCH INSTRUCTION ADDRESSING

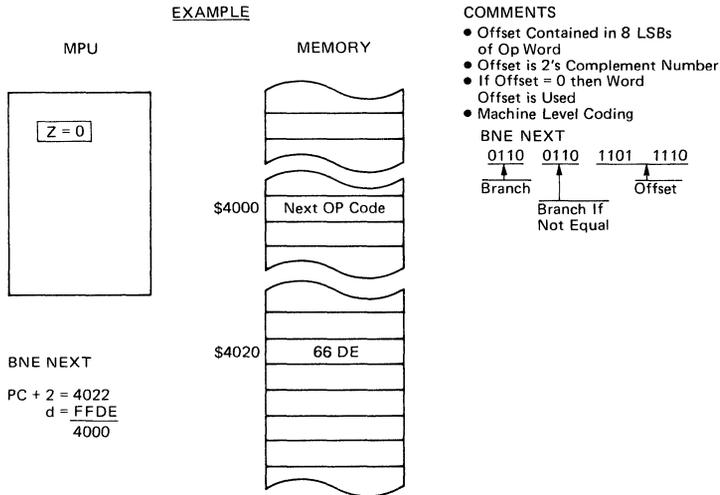
BRANCH INSTRUCTION FORMAT



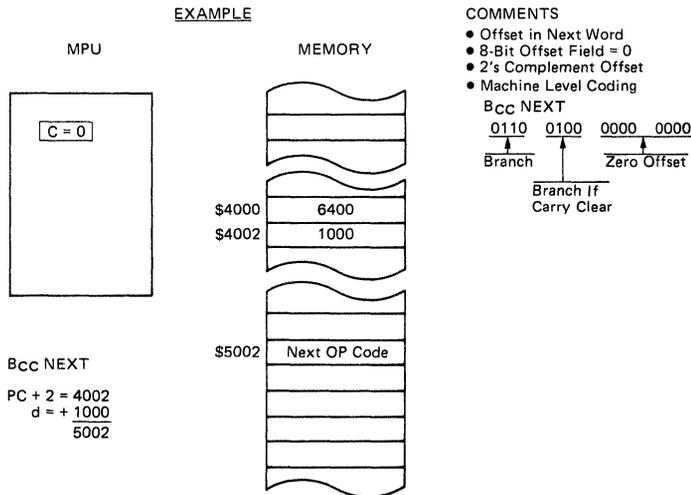
RELATIVE, FORWARD REFERENCE, 8-BIT OFFSET



RELATIVE, BACKWARD REFERENCE 8-BIT OFFSET



RELATIVE, FORWARD REFERENCE, 16-BIT OFFSET



■ **CONDITION CODES COMPUTATION**

This provides a discussion of how the condition codes were developed, the meanings of each bit, how they are computed, and how they are represented in the instruction set details.

● **CONDITION CODE REGISTER**

The condition code register portion of the status register contains five bits:

- N - Negative
- Z - Zero

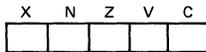
- V - Overflow
- C - Carry
- X - Extend

The first four bits are true condition code bits in that they reflect the condition of the result of a processor operation. The X-bit is an operand for multiprecision computations. The carry bit (C) and the multiprecision operand extend bit (X) are separate in the HD68000 to simplify the programming model.

● **CONDITION CODE REGISTER NOTATION**

In the instruction set details, the description of the effect on the condition codes is given in the following form:

Condition Codes:



Where

- N (negative) set if the most significant bit of the result is set. Cleared otherwise.
- Z (zero) set if the result equals zero. Cleared otherwise.
- V (overflow) set if there was an arithmetic overflow. This implies that the result is not representable in the operand size. Cleared otherwise.
- C (carry) set if a carry is generated out of the most significant bit of the operands for an addition. Also set if a borrow is generated in a subtraction. Cleared otherwise.

X (extend) transparent to data movement. When affected, it is set the same as the C-bit.

The notational convention that appears in the representation of the condition code registers is:

- * set according to the result of the operation
- not affected by the operation
- 0 cleared
- 1 set
- U undefined after the operation

● **CONDITION CODE COMPUTATION**

Most operations take a source operand and a destination operand, compute, and store the result in the destination location. Unary operations take a destination operand, compute, and store the result in the destination location. Table 22 details how each instruction sets the condition codes.

Table 22 Condition Code Computations

Operations	X	N	Z	V	C	Special Definition
ABCD	*	U	?	U	?	C = Decimal Carry Z = Z · Rm · ... · R0
ADD, ADDI, ADDQ	*	*	*	?	?	V = Sm · Dm · Rm + Sm · Dm · Rm C = Sm · Dm + Rm · Dm + Sm · Rm
ADDX	*	*	?	?	?	V = Sm · Dm · Rm + Sm · Dm · Rm C = Sm · Dm + Rm · Dm + Sm · Rm Z = Z · Rm · ... · R0
AND, ANDI, EOR, EORI, MOVEQ, MOVE, OR, ORI, CLR, EXT, NOT, TAS, TST	—	*	*	0	0	
CHK	—	*	U	U	U	
SUB, SUBI SUBQ	*	*	*	?	?	V = Sm · Dm · Rm + Sm · Dm · Rm C = Sm · Dm + Rm · Dm + Sm · Rm
SUBX	*	*	?	?	?	V = Sm · Dm · Rm + Sm · Dm · Rm C = Sm · Dm + Rm · Dm + Sm · Rm Z = Z · Rm · ... · R0
CMP, CMPI, CMPM	—	*	*	?	?	V = Sm · Dm · Rm + Sm · Dm · Rm C = Sm · Dm + Rm · Dm + Sm · Rm
DIVS, DIVU	—	*	*	?	0	V = Division Overflow
MULS, MULU	—	*	*	0	0	
SBCD, NBCD	*	U	?	U	?	C = Decimal Borrow Z = Z · Rm · ... · R0
NEG NEGX	*	*	*	?	?	V = Dm · Rm, C = Dm + Rm V = Dm · Rm, C = Dm + Rm Z = Z · Rm · ... · R0
BTST, BCHG, BSET, BCLR	—	—	?	—	—	Z = Dn
ASL	*	*	*	?	?	V = Dm · (Dm-1 + ... + Dm-r) + Dm · (Dm-1 + ... + Dm-r) C = Dm-r+1
ASL (r = 0)	—	*	*	0	0	
LSL, ROXL	—	*	*	0	?	C = Dm-r+1
LSR (r = 0)	—	*	*	0	0	
ROXL (r = 0)	—	*	*	0	?	C = X
ROL	—	*	*	0	?	C = Dm-r+1
ROL (r = 0)	—	*	*	0	0	
ASR, LSR, ROXR	*	*	*	0	?	C = Dr-1
ASR, LSR (r = 0)	—	*	*	0	0	
ROXR (r = 0)	—	*	*	0	?	C = X
ROR	—	*	*	0	?	C = Dr-1
ROR (r = 0)	—	*	*	0	0	

— Not affected
U Undefined
? Other— see Special Definition

* General Case:
X = C
N = Rm
Z = Rm · ... · R0

Sm — Source operand most significant bit
Dm — Destination operand most significant bit
Rm — Result bit most significant bit
n — bit number
r — shift amount

● **CONDITIONAL TESTS**

Table 23 lists the condition names, encodings, and tests for the conditional branch and set instructions. The test associated with each condition is a logical formula based on the current state of the condition codes. If this formula evaluates to

1, the condition succeeds, or is true. If the formula evaluates to 0, the condition is unsuccessful, or false. For example, the T condition always succeeds, while the EQ condition succeeds only if the Z bit is currently set in the condition codes.

Table 23 Conditional Tests

Mnemonic	Condition	Encoding	Test
T	true	0000	1
F	false	0001	0
HI	high	0010	$\overline{C} \cdot \overline{Z}$
LS	low or same	0011	$C + Z$
CC	carry clear	0100	\overline{C}
CS	carry set	0101	C
NE	not equal	0110	\overline{Z}
EQ	equal	0111	Z
VC	overflow clear	1000	\overline{V}
VS	overflow set	1001	V
PL	plus	1010	\overline{N}
MI	minus	1011	N
GE	greater or equal	1100	$N \cdot V + \overline{N} \cdot \overline{V}$
LT	less than	1101	$N \cdot \overline{V} + \overline{N} \cdot V$
GT	greater than	1110	$N \cdot V \cdot \overline{Z} + \overline{N} \cdot \overline{V} \cdot \overline{Z}$
LE	less or equal	1111	$Z + N \cdot \overline{V} + \overline{N} \cdot V$

■ **INSTRUCTION SET**

The following paragraphs provide information about the addressing categories and instruction set of the HD68000.

● **ADDRESSING CATEGORIES**

Effective address modes may be categorized by the ways in which they may be used. The following classifications will be used in the instruction definitions.

- Data If an effective address mode may be used to refer to data operands, it is considered a data addressing effective address mode.
- Memory If an effective address mode may be used to refer to memory operands, it is considered a memory addressing effective address mode.
- Alterable If an effective address mode may be used to refer to alterable (writable) operands, it is considered an alterable addressing effective address mode.
- Control If an effective address mode may be used to refer to memory operands without an associated size, it is considered a control addressing effective address mode.

Table 24 shows the various categories to which each of the effective address modes belong. Table 25 is the instruction set summary.

The status register addressing mode is not permitted unless it is explicitly mentioned as a legal addressing mode.

These categories may be combined so that additional, more restrictive, classifications may be defined. For example, the instruction descriptions use such classifications as alterable

memory or data alterable. The former refers to those addressing modes which are both alterable and memory addresses, and the latter refers to addressing modes which are both data and alterable.

● **INSTRUCTION PRE-FETCH**

The HD68000 uses a 2-word tightly-coupled instruction prefetch mechanism to enhance performance. This mechanism is described in terms of the microcode operations involved. If the execution of an instruction is defined to begin when the microroutine for that instruction is entered, some features of the prefetch mechanism can be described.

- 1) When execution of an instruction begins, the operation word and the word following have already been fetched. The operation word is in the instruction decoder.
- 2) In the case of multi-word instructions, as each additional word of the instruction is used internally, a fetch is made to the instruction stream to replace it.
- 3) The last fetch from the instruction stream is made when the operation word is discarded and decoding is started on the next instruction.
- 4) If the instruction is a single-word instruction causing a branch, the second word is not used. But because this word is fetched by the preceding instruction, it is impossible to avoid this superfluous fetch. In the case of an interrupt or trace exception, both words are not used.
- 5) The program counter usually points to the last word fetched from the instruction stream.

Table 24 Effective Addressing Mode Categories

Effective Address Modes	Mode	Register	Data	Addressing Categories		
				Memory	Control	Alterable
Dn	000	register number	X	—	—	X
An	001	register number	—	—	—	X
An@	010	register number	X	X	X	X
An@+	011	register number	X	X	—	X
An@-	100	register number	X	X	—	X
An@(d)	101	register number	X	X	X	X
An@(d, ix)	110	register number	X	X	X	X
xxx.W	111	000	X	X	X	X
xxx.L	111	001	X	X	X	X
PC@(d)	111	010	X	X	X	—
PC@(d, ix)	111	011	X	X	X	—
#xxx	111	100	X	X	—	—

The following example illustrates many of the features of instruction prefetch. The contents of memory are assumed to be as illustrated in Figure 53.

ORG	0	DEFINE RESTART VECTOR
DC.L	INISSP	INITIAL SYSTEM STACK POINTER
DC.L	RESTART	RESTART SYSTEM ENTRY POINT
ORG	INTVECTOR	DEFINE AN INTERRUPT VECTOR
DC.L	INTHANDLER	HANDLER ADDRESS FOR THIS VECTOR
ORG		SYSTEM RESTART CODE
RESTART:		
NOP		NO OPERATION EXAMPLE
BRA.S	LABEL	SHORT BRANCH
ADD.W	D0, D1	ADD REGISTER TO REGISTER
LABEL:		
SUB.W	DISP(A0), A1	SUBTRACT REGISTER INDIRECT WITH OFFSET
CMP.W	D2, D3	COMPARE REGISTER TO REGISTER
SGE.B	D7	ScC TO REGISTER
...		
INTHANDLER:		
MOVE.W	LONGADR1, LONGADR2	MOVE WORD FROM AND TO LONG ADDRESS
NOP		NO OPERATION
SWAP.W		REGISTER SWAP

Figure 53 Instruction Prefetch Example, Memory Contents

The sequence we shall illustrate consists of the power-up reset, the execution of NOP, BRA, SUB, the taking of an interrupt, and the execution of the MOVE.W xxx.L to yyy.L.

The order of operations described within each microroutine is not exact, but is intended for illustrative purpose only.

Microroutine	Operation	Location	Operand
Reset	Read	0	SSP High
	Read	2	SSP Low
	Read	4	PC High
	Read	6	PC Low
	Read	(PC)	NOP
	Read	+(PC)	BRA
	<begin NOP>		
NOP	Read	+(PC)	ADD
	<begin BRA>		
BRA	PC=PC+d		
	Read	(PC)	SUB
	Read	+(PC)	DISP
	<begin SUB>		
SUB	Read	+(PC)	CMP
	Read	DISP(A0)	<src>
	Read	+(PC)	SGE
	<begin CMP>	<take INT>	
INTERRUPT	Write	-(SSP)	PC Low
	Read	<INT ACK>	Vector #
	Write	-(SSP)	SR
	Write	-(SSP)	PC High
	Read	(VR)	PC High
	Read	+(VR)	PC Low
	Read	(PC)	MOVE
	Read	+(PC)	xxx High
	<begin MOVE>		
MOVE	Read	+(PC)	xxx Low
	Read	+(PC)	yyy High
	Read	xxx	<src>
	Read	+(PC)	yyy Low
	Write	yyy	<dest>
	Read	+(PC)	NOP
	Read	+(PC)	SWAP
	<begin NOP>		

Figure 54 Instruction Prefetch Example

• DATA PREFETCH

Normally the HD68000 prefetches only instructions and not data. However, when the MOVEM instruction is used to move data from memory to registers, the data stream is prefetched in

order to optimize performance. As a result, the processor reads one extra word beyond the higher end of the source area. For example, the instruction sequence in Figure 55 will operate as shown in Figure 56.

	MOVEM.L	A, D0/D1	MOVE TWO LONGWORDS INTO REGISTERS
A	DC.W	1	WORD 1
B	DC.W	2	WORD 2
C	DC.W	3	WORD 3
D	DC.W	4	WORD 4
E	DC.W	5	WORD 5
F	DC.W	6	WORD 6

Figure 55 MOVEM Example, Memory Contents

Assume Effective Address Evaluation is Already Done

Microroutine	Operation	Location	Other Operations
MOVEM	...		
	Read	A	
			Prepare to Fill D0
	Read	B	A → DOH
	Read	C	B → DOL
			Prepare to Fill D1
	Read	D	C → D1H
	Read	E	D → D1L
			Detect Register List Complete

Figure 56 MOVEM Example, Operation Sequence

Table 25 Instruction Set

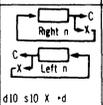
Mnemonic Operation	Size	Addr. Mode	Dn		An		(An)		(An) +		-(An)		d(An)		d(An,X)		Abs.W		Abs.L		d(PC)		d(PC,X)		s=Immed d=SR/CC		Opcode Bit Pattern				Boolean	Condition Codes XNZVC
			#	~	#	~	#	~	#	~	#	~	#	~	#	~	#	~	#	~	#	~	#	~	#	~	#	~	#	~		
ABCD Add Digits	B	s:Dn	d	2	6																						1100 RRR1	0000 0rrr	d10+s10+X+d	*U*U*		
ADD Add	B/W	s:Dn	d	2	6																					1100 RRR1	0000 1rrr	d+Dn+d	*****			
ADD Add Binary	L	s:Dn	d	2	4	2*	4	2	8	2	2	2	10	4	12	4	14	4	12	6	16	4	12	4	14	4	8	1101 DDD1	SSEE EEEE	Dn+s-Dn	*****	
ADDA Add Address	W	d:An	s	2	8	2	8	2	12	2	12	2	14	4	16	4	18	4	16	6	20	4	18	4	20	6	14	1101 DDD1	10ee eeee	Dn+s-Dn	-----	
ADDI Add Immed	B/W	s:Imm	d	4	8																					1101 AAA1	11ee eeee	An+s-An	-----			
ADDQ Add Quick	L	s:Imm3	d	2	4	2*	4	2	12	2	12	2	14	4	16	4	18	4	16	6	20	4	18	4	20	6	14	0000 0110	SSEE EEEE	d+#-d	*****	
ADDX Add Multi-precision	L	s:(An) s:(An) s:(An)	d	2	8																					1101 RRR1	S500 0rrr	d-s+X+d	*****			
AND Logical And	B/W	s:Dn	d	2	4																					1101 RRR1	1000 1rrr	d<and>Dn+d	---*0			
ANDI And Immed	L	s:Imm	d	2	4																					1100 DDD1	SSEE EEEE	d<and>s-Dn	-----			
ASL,ASR Arithmetic Shift	B/W	count:Dn	d	2	6+2n																					1100 DDD1	10ee eeee	Dn<and>s-Dn	-----			
ASL,ASR Arithmetic Shift	L	count:#1-8	d	2	8+2n																					1100 DDD1	10ee eeee	Dn<and>s-Dn	-----			
ASL,ASR Arithmetic Shift	W	count:#1-8	d	2	8+2n																					0000 0010	SSEE EEEE	d<and>#-d	---*0			
BCHG Test and Change	B	bit:#Dn	d	2	<8																					1110 rrrr	S510 0DDD	C X ← Left Right → X	*****			
BCLR Test and Clear	L	bit:#Imm	d	2	<12																					0000 rrrr	01EE EEEE	-(bit)# of d→Z	---*-			
BSET Test and Set	B	bit:#Dn	d	2	<8																					0000 rrrr	01EE EEEE	-(bit)# of d	---*-			
BTST Bit Test	L	bit:#Imm	d	2	<12																					0000 rrrr	01EE EEEE	-(bit)# of d→Z	---*-			
CHK Check Register Against Bounds	W	d:Dn	s	2	<10																					0000 rrrr	10EE EEEE	0-(bit)# of d	---*-			
CLR Clear Operand	B/W	d:Dn	s	2	4																					0000 rrrr	11EE EEEE	-(bit)# of d→Z	---*-			
CMP Compare Binary	L	d:Dn	s	2	4	2*	4	2	8	2	2	10	4	12	4	14	4	12	6	16	4	12	4	14	4	8	1011 DDD0	SSee eeee	Dn-s	*****		
CMPI Compare Immed	B/W	s:Imm	d	4	8																					1011 AAA0	11ee eeee	An-s	*****			
CMPL Compare Long	L	s:Imm	d	6	14																					1011 AAA1	11ee eeee	An-s	*****			
CMPL Compare Long	B/W	s:(An)+ s:(An)+	d	4	8																					0000 1100	SSEE EEEE	d-#	*****			
CMPL Compare Long	L	s:(An)+ s:(An)+	d	6	14																					1011 RRR1	S500 1rrr	d-s	*****			
DIVS Divide Signed	W	d:Dn	s	2	<158																					1000 DDD1	11ee eeee	Dn32/s16→ Dn(r,q)	-----			
DIVU Divide Unsigned	W	d:Dn	s	2	<140																					1000 DDD0	11ee eeee	Dn32/s16→ Dn(r,q)	-----			
EXOR Exclusive OR	B/W	s:Dn	d	2	4																					1011 rrrr	SSEE EEEE	d*Dn→d	---*0			
EXOR Exclusive OR	L	s:Dn	d	2	8																					0000 1010	SSEE EEEE	d*#-d	---*0			
EXT Sign Extend	L	s:An	d	2	6																					1100 DDD1	0100 0DDD	s→d	-----			
LEA Load Effective Address	W	d:An	s	2	4																					1100 AAA1	0100 1AAA	An→-(SP)	-----			
LINK Link and Allocate	W	d:An	s	2	4																					1100 DDD1	0100 1AAA	SP→An	-----			
LINK Link and Allocate	W	d:An	s	2	4																					1100 DDD1	0100 1AAA	SP+disp→SP	-----			

Note 1: Refer to Condition Code Computations as for condition Code
 * Word only
 < Maximum value
 #: Number of Program Bytes
 ~: Number of Cycles Periods

Opcode Bit Pattern Key
 A. Address Register #
 C. Test Condition
 D. Data Register #
 E. Source Effective Address
 E. Destination Effective Address
 1. Direction, 0-Right, 1-Left
 M. Destination EA Mode
 P. Displacement
 Q. Quick Immediate Data
 r. Source Register
 R. Destination Register
 S. Size, 00-Byte
 01-Word
 10-Long Word
 11-Another Operation
 V. Vector #

(In the MOVE Instruction)
 01-Byte
 10-Long Word
 11-Word

(to be continued)

Mnemonic Operation	Size	Addr. Mode	Dn		An		(An)		(An) +		-(An)		d(An)		d(An.X)		Abs W		Abs.L		d(PC)		d(PC.X)		s=Immed d=SR/CC		Opcode Bit Pattern				Boolean	Condition Codes XNZVC
			#	~	#	~	#	~	#	~	#	~	#	~	#	~	#	~	#	~	#	~	#	~	#	~	1111 11	5432 1098	7654 3210			
ROXR,ROXL Rotate through X	B L	count:Dn count:#-8d count:Dn count:#-8d	d: d: d: d:	2 6+2n 2 8+2n	2 6+2n 2 8+2n																				1110 rrrf 1110 QQQf 1110 rrrf 1110 QQQf 1110 010f 1000 RRRf 1000 RRRf	SS11 0DDd SS01 0DDd 1011 0DDd 1001 0DDd 11EE EEEe 0000 0rrr 0000 1rrr		****				
SBCD Subtract digits	B	count:1 s:(An)	d: d:	2 6				2*	12	2*	12	2*	14	4*	16	4*	18	4*	16	6*	20					0101 CCCC 11EE EEEe	d-MPU If cc true 1s'd Else 0s'd	****				
SEC Set Conditionally	B	cc	d:	2	6	4			2	12	2	12	2	14	4	16	4	18	4	16	6	20				0101 CCCC 11EE EEEe	d-MPU If cc true 1s'd Else 0s'd	****				
SUB Subtract	B	s:Dn	d: s:	2 4	4	2	4	2*	12	2	12	2	14	4	16	4	18	4	16	6	20	4	8		1001 DDDd 1001 DDDd 1001 DDDd 1001 DDDd	SSEE EEEe SSEE EEEe 10EE EEEe 11EE EEEe	d Dn + Dn s +Dn d Dn + Dn s +Dn	****				
SUBA Subtract Address	L	d:An	s:	2	8	2	8	2	12	2	12	2	14	4	16	4	18	4	16	6	20	4	12	6	14	1001 AAAA 1001 AAAA	11EE EEEe 11EE EEEe	An s +An	****			
SUBI Subtract Immediate	B	s:imm	d: s:	4 6	4	6	16	4	16	4	16	4	18	6	20	6	22	6	20	8	24	10	36		0000 0100 0000 0100	SSEE EEEe SSEE EEEe	d = +d	****				
SUBQ Subtract Quick	B	s:imm3	d: s:	2 2	4	2	4	2*	12	2	12	2	14	4	16	4	18	4	16	6	20	2	28		0101 QQQf 0101 QQQf	SSEE EEEe SSEE EEEe	d = +d	****				
SUBX Subtract Multiprecision	B	s:(An)	d: s:	2 2	4	2	8					2	18												1001 RRRf 1001 RRRf 1001 RRRf 1001 RRRf	SS00 0rrr SS00 1rrr 1000 0rrr 1000 1rrr	d s X +d	****				
SWAP Swap Regis ter Halves	W		d: d:	2 2	4	2	4					2	30												0100 1000 0100 1000	0100 0DDd 0100 0DDd	Dn(31:16) + Dn(15:0)	-**00				
TAS Test and Set Operand	B		d:	2	4	4			2	14	2	14	2	16	4	18	4	20	4	18	6	22			0100 1010 0100 1010	11EE EEEe 11EE EEEe	test d +cc 1-bit 7 of d	-**00				
TST Test	B		d: d:	2 2	4	2	4		2	8	2	8	2	10	4	12	4	14	4	12	6	16	20		0100 1010 0100 1110	SSEE EEEe 0101 1AAA	test d +cc An -SP (SP) - +An	-**00 -----				
UNLK Unlink	L		d:	2	4	2	12					2	14	4	16	4	18	4	16	6	20			0100 1110	0101 1AAA	An -SP (SP) - +An	-----					

Bcc Branch Conditionally	B W	disp: disp																							0110 CCCC 0110 CCCC 0110 0000 0110 0001	PPPP PPPP PPPP PPPP PC - disp +PC PC - (SP) PC - disp +PC	if cc true PC - disp +PC	----- ----- ----- -----
BRA Branch Always	B W	disp: disp																							0110 0000 0110 0001	PPPP PPPP PPPP PPPP	PC - disp +PC PC - (SP) PC - disp +PC	----- -----
BSR Branch to Subroutine	B W	disp: disp																							0110 0001 0101 CCCC	PPPP PPPP 1100 1DDD	PC - (SP) PC - disp +PC If cc false Dn 1 +Dn & if Dn = 1 PC - disp +PC Else NOP	----- -----
DBcc Decrement Counter, & Branch Until Condition True or Count = 1	W	disp:imm counter:	d: d:	4 12 14				cc	Counter	Branch															0101 CCCC 0100 1110 0100 1110	1100 1DDD 11EE EEEe 10EE EEEe	If cc false Dn 1 +Dn & if Dn = 1 PC - disp +PC Else NOP	----- ----- -----
JMP Jump to			d:						2	8			4	10	4	14	4	10	6	12	4	10	4	14	0100 1110 0100 1110	11EE EEEe 10EE EEEe	d +PC PC + (SP) d +PC	----- -----
JSR Jump to Subroutine			d:						2	16			4	18	4	22	4	18	6	20	4	18	4	22	0100 1110 0100 1110	10EE EEEe 0111 0001	PC + (SP) d +PC none	----- -----
NOP No Operation				2	4																			0100 1110 0100 1110	0111 0001 0111 0000	assert RESET Dn	----- -----	
RESET Reset Exter nal Devices				2	132																			0100 1110	0111 0000	assert RESET Dn	-----	
RTI Return from Exception				2	20																			0100 1110	0111 0011	(SP) - -SR (SP) + +PC	*****	
RTR Return from Subroutine				2	20																			0100 1110	0111 0111	(SP) + +OC (SP) + +PC	*****	
RTS Return from Subroutine				2	16																			0100 1110	0111 0101	(SP) + +PC	-----	
STOP Load SR/Stop				2	34																			0100 1110 0100 1110	0111 0010 0100 VVVV	= +SR Wait for interrupt PC + (SSP) SR + (SSP) (Vector) +PC	***** -----	
TRAP Trap				2	34																			0100 1110	0111 0110	If V 1 then PC + -SSP) SR + (SSP) (TRAP vector) +PC else NOP	-----	

Note * Refer to Condition Code Computations as for condition Code
 # Word only
 < Maximum value
 #: Number of Program Bytes
 ~: Number of Clock Periods

A: Address Register #
 C: Test Condition
 D: Data Register #
 e: Source Effective Address
 E: Destination Effective Address

Opcode Bit Pattern Key
 f: Direction, 0-Right, 1-Left
 M: Destination EA Mode
 P: Displacement
 Q: Quick Immediate Data
 r: Source Register
 R: Destination Register
 S: Size, 00-Byte
 01-Word
 10-Long Word
 11-Another Operation
 V: Vector #

(In the MOVE Instruction)
 01-Byte
 10-Long Word
 11-Word

■ INSTRUCTION FORMAT SUMMARY

This provides a summary of the first word in each instruction of the instruction set. Table 26 is an operation code (op-code) map which illustrates how bits 15 through 12 are used to specify the operations. The remaining paragraph groups the

instructions according to the op-code map.

where, Size; Byte = 00 Sz; Word = 0
 Word = 01 Long Word = 1
 Long Word = 10

Table 26 Operation Code Map

Bits 15 thru 12	Operation
0000	Bit Manipulation/MOVEP/Immediate
0001	Move Byte
0010	Move Long
0011	Move Word
0100	Miscellaneous
0101	ADDQ/SUBQ/S _{CC} /DB _{CC}
0110	B _{CC}
0111	MOVEQ
1000	OR/DIV/SBCD
1001	SUB/SUBX
1010	(Unassigned)
1011	CMP/EOR
1100	AND/MUL/ABCD/EXG
1101	ADD/ADDX
1110	Shift/Rotate
1111	(Unassigned)

(1) BIT MANIPULATION, MOVE PERIPHERAL, IMMEDIATE INSTRUCTIONS

Dynamic Bit

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	Register	1	Type	Effective Address								

Static Bit

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	1	0	0	0	Type	Effective Address						

Bit Type Codes: TST = 00, CHG = 01, CLR = 10, SET = 11

MOVEP

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	Register	Op-Mode	0	0	1	Register						

Op-Mode; Word to Reg = 100, Long to Reg = 101, Word to Mem = 110, Long to Mem = 111

OR Immediate

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	Size	Effective Address						

AND Immediate

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	1	0	Size	Effective Address						

SUB Immediate

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	1	0	0	Size			Effective Address				

ADD Immediate

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	1	1	0	Size			Effective Address				

EOR Immediate

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	1	0	1	0	Size			Effective Address				

CMP Immediate

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	1	1	0	0	Size			Effective Address				

(2) MOVE BYTE INSTRUCTION

MOVE Byte

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	1	Destination Register				Mode		Source Mode		Register			

(3) MOVE LONG INSTRUCTION

MOVE Long

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	1	0	Destination Register				Mode		Source Mode		Register			

(4) MOVE WORD INSTRUCTION

MOVE Word

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	1	1	Destination Register				Mode		Source Mode		Register			

(5) MISCELLANEOUS INSTRUCTIONS

NEGX

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	1	0	0	0	0	0	0	Size			Effective Address				

MOVE from SR

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	1	0	0	0	0	0	0	1	1	Effective Address					

CLR

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	1	0	0	0	0	1	0	Size			Effective Address				

NEG

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	1	0	0	0	1	0	0		Size	Effective Address					

MOVE to CCR

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	1	0	0	0	1	0	0	1	1	Effective Address					

NOT

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	1	0	0	0	1	1	0		Size	Effective Address					

MOVE to SR

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	1	0	0	0	1	1	0	1	1	Effective Address					

NBCD

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	1	0	0	1	0	0	0	0	0	Effective Address					

PEA

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	1	0	0	1	0	0	0	0	1	Effective Address					

SWAP

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	1	0	0	1	0	0	0	0	1	0	0	0	Register		

MOVEM Registers to EA

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	1	0	0	1	0	0	0	1	Sz	Effective Address					

EXTW

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	1	0	0	1	0	0	0	1	0	0	0	0	Register		

EXTL

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	1	0	0	1	0	0	0	1	1	0	0	0	Register		

TST

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	1	0	0	1	0	1	0		Size	Effective Address					

TAS

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	1	0	0	1	0	1	0	1	1	Effective Address					

MOVEM EA to Registers

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	1	0	0	1	1	0	0	1	Sz	Effective Address					

TRAP

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	1	0	0	1	1	1	0	0	1	0	0	Vector			

LINK

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	1	0	0	1	1	1	0	0	1	0	1	0	Register		

UNLK

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	1	0	0	1	1	1	0	0	1	0	1	1	Register		

MOVE to USP

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	1	0	0	1	1	1	0	0	1	1	0	0	Register		

MOVE from USP

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	1	0	0	1	1	1	0	0	1	1	0	1	Register		

RESET

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	1	0	0	1	1	1	0	0	1	1	1	0	0	0	0

NOP

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	1	0	0	1	1	1	0	0	1	1	1	0	0	0	1

STOP

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	1	0	0	1	1	1	0	0	1	1	1	0	0	1	0

RTE

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	1	0	0	1	1	1	0	0	1	1	1	0	0	1	1

RTS

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	1	0	0	1	1	1	0	0	1	1	1	0	1	0	1

TRAPV

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	1	0	0	1	1	1	0	0	1	1	1	0	1	1	0

RTR

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	1	0	0	1	1	1	0	0	1	1	1	0	1	1	1

JSR

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	1	0	0	1	1	1	0	1	0	Effective Address					

JMP

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	1	0	0	1	1	1	0	1	1	Effective Address					

CHK

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	1	0	0	Register			1	1	0	Effective Address					

LEA

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	1	0	0	Register			1	1	1	Effective Address					

(6) ADD QUICK, SUBTRACT QUICK, SET CONDITIONALLY, DECREMENT INSTRUCTIONS

ADDQ

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	1	0	1	Data			0	Size		Effective Address					

SUBQ

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	1	0	1	Data			1	Size		Effective Address					

S_{CC}

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	1	0	1	Condition			1	1	Effective Address						

DB_{CC}

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	1	0	1	Condition			1	1	0	0	1	Register			

(7) BRANCH CONDITIONALLY, BRANCH TO SUBROUTINE INSTRUCTION

B_{CC}

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	1	1	0	Condition			8 bit Displacement								

BSR

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	1	1	0	0	0	0	1	8 bit Displacement							

(8) MOVE QUICK INSTRUCTION

MOVEQ

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	1	1	1	Register			0	Data							

(9) OR, DIVIDE, SUBTRACT DECIMAL INSTRUCTIONS

OR

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
1	0	0	0	Register			Op-Mode			Effective Address					

Op-Mode

B	W	L	
000	001	010	Dn ∨ EA → Dn
100	101	110	EA ∨ Dn → EA

DIVU

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
1	0	0	0	Register			0	1	1	Effective Address					

DIVS

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
1	0	0	0	Register			1	1	1	Effective Address					

SBCD

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
1	0	0	0	Destination Register			1	0	0	0	0	R/M	Source Register			

R/M (register/memory): register – register = 0, memory – memory = 1

(10) SUBTRACT, SUBTRACT EXTENDED INSTRUCTIONS

SUB

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
1	0	0	1	Register			Op-Mode			Effective Address					

Op-Mode

B	W	L	
000	001	010	Dn – EA → Dn
100	101	110	EA – Dn → EA
–	011	111	An – EA → An

SUBX

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
1	0	0	1	Destination Register			1	Size	0	0	R/M	Source Register			

R/M (register/memory): register – register = 0, memory – memory = 1

(11) COMPARE, EXCLUSIVE OR INSTRUCTIONS

CMP

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
1	0	1	1	Register			Op-Mode			Effective Address					

Op-Mode

B	W	L	
000	001	010	Dn – EA
–	011	111	An – EA

CMPM

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
1	0	1	1	Register			1	Size	0	0	1	Register			

EOR

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
1	0	1	1	Register			1	Size	Effective Address						

(12) AND, MULTIPLY, ADD DECIMAL, EXCHANGE INSTRUCTIONS

AND

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
1	1	0	0	Register			Op-Mode			Effective Address					

Op-Mode

B	W	L	
000	001	010	Dn ∧ EA → Dn
100	101	110	EA ∧ Dn → EA

MULU

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
1	1	0	0	Register			0	1	1	Effective Address					

MULS

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
1	1	0	0	Register			1	1	1	Effective Address					

ABCD

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
1	1	0	0	Destination Register		1	0	0	0	0	R/M	Source Register			

R/M (register/memory): register – register = 0, memory – memory = 1

EXGD

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
1	1	0	0	Data Register			1	0	1	0	0	0	Data Register		

EXGA

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
1	1	0	0	Address Register			1	0	1	0	0	1	Address Register		

EXGM

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
1	1	0	0	Data Register			1	1	0	0	0	1	Address Register		

(13) ADD, ADD EXTENDED INSTRUCTIONS

ADD

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
1	1	0	1	Register			Op-Mode			Effective Address					

			Op-Mode			
B	W	L	000	001	010	$D_n + EA \rightarrow D_n$
			100	101	110	$EA + D_n \rightarrow EA$
			—	011	111	$A_n + EA \rightarrow A_n$

ADDX

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
1	1	0	1	Destination Register		1	Size		0	0	R/M	Source Register			

R/M (register/memory): register – register = 0, memory – memory = 1

(14) SHIFT/ROTATE INSTRUCTIONS

Data Register Shifts

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
1	1	1	0	Count/Register		d	Size		i/r	Type		Register			

Memory Shifts

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
1	1	1	0	0	Type	d	1	1	Effective Address						

Shift Type Codes: AS = 00, LS = 01, ROX = 10, RO = 11

d (direction): Right = 0, Left = 1

i/r (count source): Immediate Count = 0, Register Count = 1

■ INSTRUCTION EXECUTION TIMES

The following paragraphs contain listings of the instruction execution times in terms of external clock (CLK) periods. In this timing data, it is assumed that both memory read and write cycle times are four clock periods. Any wait states caused by a longer memory cycle must be added to the total instruction time. The number of bus read and write cycles for each instruction is also included with the timing data. This data is enclosed in parenthesis following the execution periods and is shown as: (r/w) where r is the number of read cycles and w is the number of write cycles.

(NOTE) The number of periods includes instruction fetch and all applicable operand fetches and stores.

● EFFECTIVE ADDRESS OPERAND CALCULATION TIMING

Table 27 lists the number of clock periods required to compute an instruction's effective address. It includes fetching of any extension words, the address computation, and fetching of the memory operand. The number of bus read and write cycles is shown in parenthesis as (r/w). Note there are no write cycles involved in processing the effective address.

● MOVE INSTRUCTION CLOCK PERIODS

Table 28 and 29 indicate the number of clock periods for the move instruction. This data includes instruction fetch, operand reads, and operand writes. The number of bus read and write cycles is shown in parenthesis as: (r/w).

● STANDARD INSTRUCTION CLOCK PERIODS

The number of clock periods shown in Table 30 indicates

the time required to perform the operations, store the results, and read the next instruction. The number of bus read and write cycles is shown in parenthesis as: (r/w). The number of clock periods and the number of read and write cycles must be added respectively to those of the effective address calculation where indicated.

In Table 30 the headings have the following meanings: An = address register operand, Dn = data register operand, ea = an operand specified by an effective address, and M = memory effective address operand.

● IMMEDIATE INSTRUCTION CLOCK PERIODS

The number of clock periods shown in Table 31 includes the time to fetch immediate operands, perform the operations, store the results, and read the next operation. The number of bus read and write cycles is shown in parenthesis as: (r/w). The number of clock periods and the number of read and write cycles must be added respectively to those of the effective address calculation where indicated.

In Table 31, the headings have the following meanings: # = immediate operand, Dn = data register operand, An = address register operand, M = memory operand, CCR = condition code register, and SR = status register.

● SINGLE OPERAND INSTRUCTION CLOCK PERIODS

Table 32 indicates the number of clock periods for the single operand instructions. The number of bus read and write cycles is shown in parenthesis as: (r/w). The number of clock periods and the number of read and write cycles must be added respectively to those of the effective address calculation where indicated.

Table 27 Effective Address Calculation Timing

Addressing Mode		Byte, Word	Long
Register			
Dn	Data Register Direct	0(0/0)	0(0/0)
An	Address Register Direct	0(0/0)	0(0/0)
Memory			
An@	Address Register Indirect	4(1/0)	8(2/0)
An@ +	Address Register Indirect with Postincrement	4(1/0)	8(2/0)
An@ -	Address Register Indirect with Predecrement	6(1/0)	10(2/0)
An@(d)	Address Register Indirect with Displacement	8(2/0)	12(3/0)
An@(d, ix)*	Address Register Indirect with Index	10(2/0)	14(3/0)
xxx.W	Absolute Short	8(2/0)	12(3/0)
xxx.L	Absolute Long	12(3/0)	16(4/0)
PC@(d)	Program Counter with Displacement	8(2/0)	12(3/0)
PC@(d, ix)*	Program Counter with Index	10(2/0)	14(3/0)
#xxx	Immediate	4(1/0)	8(2/0)

* The size of the index register (ix) does not affect execution time.

Table 28 Move Byte and Word Instruction Clock Periods

Source	Destination								
	Dn	An	An@	An@ +	An@ -	An@(d)	An@(d, ix)*	xxx.W	xxx.L
Dn	4(1/0)	4(1/0)	8(1/1)	8(1/1)	8(1/1)	12(2/1)	14(2/1)	12(2/1)	16(3/1)
An	4(1/0)	4(1/0)	8(1/1)	8(1/1)	8(1/1)	12(2/1)	14(2/1)	12(2/1)	16(3/1)
An@	8(2/0)	8(2/0)	12(2/1)	12(2/1)	12(2/1)	16(3/1)	18(3/1)	16(3/1)	20(4/1)
An@ +	8(2/0)	8(2/0)	12(2/1)	12(2/1)	12(2/1)	16(3/1)	18(3/1)	16(3/1)	20(4/1)
An@ -	10(2/0)	10(2/0)	14(2/1)	14(2/1)	14(2/1)	18(3/1)	20(3/1)	18(3/1)	22(4/1)
An@(d)	12(3/0)	12(3/0)	16(3/1)	16(3/1)	16(3/1)	20(4/1)	22(4/1)	20(4/1)	24(5/1)
An@(d, ix)*	14(3/0)	14(3/0)	18(3/1)	18(3/1)	18(3/1)	22(4/1)	24(4/1)	22(4/1)	26(5/1)
xxx.W	12(3/0)	12(3/0)	16(3/1)	16(3/1)	16(3/1)	20(4/1)	22(4/1)	20(4/1)	24(5/1)
xxx.L	16(4/0)	16(4/0)	20(4/1)	20(4/1)	20(4/1)	24(5/1)	26(5/1)	24(5/1)	28(6/1)
PC@(d)	12(3/0)	12(3/0)	16(3/1)	16(3/1)	16(3/1)	20(4/1)	22(4/1)	20(4/1)	24(5/1)
PC@(d, ix)*	14(3/0)	14(3/0)	18(3/1)	18(3/1)	18(3/1)	22(4/1)	24(4/1)	22(4/1)	26(5/1)
#xxx	8(2/0)	8(2/0)	12(2/1)	12(2/1)	12(2/1)	16(3/1)	18(3/1)	16(3/1)	20(4/1)

* The size of the index register (ix) does not affect execution time.

Table 29 Move Long Instruction Clock Periods

Source	Destination								
	Dn	An	An@	An@ +	An@ -	An@(d)	An@(d, ix)*	xxx.W	xxx.L
Dn	4(1/0)	4(1/0)	12(1/2)	12(1/2)	12(1/2)	16(2/2)	18(2/2)	16(2/2)	20(3/2)
An	4(1/0)	4(1/0)	12(1/2)	12(1/2)	12(1/2)	16(2/2)	18(2/2)	16(2/2)	20(3/2)
An@	12(3/0)	12(3/0)	20(3/2)	20(3/2)	20(3/2)	24(4/2)	26(4/2)	24(4/2)	28(5/2)
An@ +	12(3/0)	12(3/0)	20(3/2)	20(3/2)	20(3/2)	24(4/2)	26(4/2)	24(4/2)	28(5/2)
An@ -	14(3/0)	14(3/0)	22(3/2)	22(3/2)	22(3/2)	26(4/2)	28(4/2)	26(4/2)	30(5/2)
An@(d)	16(4/0)	16(4/0)	24(4/2)	24(4/2)	24(4/2)	28(5/2)	30(5/2)	28(5/2)	32(6/2)
An@(d, ix)*	18(4/0)	18(4/0)	26(4/2)	26(4/2)	26(4/2)	30(5/2)	32(5/2)	30(5/2)	34(6/2)
xxx.W	16(4/0)	16(4/0)	24(4/2)	24(4/2)	24(4/2)	28(5/2)	30(5/2)	28(5/2)	32(6/2)
xxx.L	20(5/0)	20(5/0)	28(5/2)	28(5/2)	28(5/2)	32(6/2)	34(6/2)	32(6/2)	36(7/2)
PC@(d)	16(4/0)	16(4/0)	24(4/2)	24(4/2)	24(4/2)	28(5/2)	30(5/2)	28(5/2)	32(6/2)
PC@(d, ix)*	18(4/0)	18(4/0)	26(4/2)	26(4/2)	26(4/2)	30(5/2)	32(5/2)	30(5/2)	34(6/2)
#xxx	12(3/0)	12(3/0)	20(3/2)	20(3/2)	20(3/2)	24(4/2)	26(4/2)	24(4/2)	28(5/2)

* The size of the index register (ix) does not affect execution time.

Table 30 Standard Instruction Clock Periods

Instruction	Size	op < ea >, An	op < ea >, Dn	op Dn, < M >
ADD	Byte, Word	8(1/0) +	4(1/0) +	8(1/1) +
	Long	6(1/0) + **	6(1/0) + **	12(1/2) +
AND	Byte, Word	-	4(1/0) +	8(1/1) +
	Long	-	6(1/0) + **	12(1/2) +
CMP	Byte, Word	6(1/0) +	4(1/0) +	-
	Long	6(1/0) +	6(1/0) +	-
DIVS	-	-	158(1/0) + *	-
DIVU	-	-	140(1/0) + *	-
EOR	Byte, Word	-	4(1/0) ***	8(1/1) +
	Long	-	8(1/0) ***	12(1/2) +
MULS	-	-	70(1/0) + *	-
MULU	-	-	70(1/0) + *	-
OR	Byte, Word	-	4(1/0) +	8(1/1) +
	Long	-	6(1/0) + **	12(1/2) +
SUB	Byte, Word	8(1/0) +	4(1/0) +	8(1/1) +
	Long	6(1/0) + **	6(1/0) + **	12(1/2) +

+ add effective address calculation time

* indicates maximum value

** total of 8 clock periods for instruction if the effective address is register direct

*** only available effective address mode is data register direct

Table 31 Immediation Instruction Clock Periods

Instruction	Size	op #, Dn	op #, An	op #, M	op #, CCR/SR
ADDI	Byte, Word	8(2/0)	—	12(2/1) +	—
	Long	16(3/0)	—	20(3/2) +	—
ADDQ	Byte, Word	4(1/0)	8(1/0)*	8(1/1) +	—
	Long	8(1/0)	8(1/0)	12(1/2) +	—
ANDI	Byte, Word	8(2/0)	—	12(2/1) +	20(3/0)
	Long	16(3/0)	—	20(3/1) +	—
CMPI	Byte, Word	8(2/0)	8(2/0)	8(2/0) +	—
	Long	14(3/0)	14(3/0)	12(3/0) +	—
EORI	Byte, Word	8(2/0)	—	12(2/1) +	20(3/0)
	Long	16(3/0)	—	20(3/2) +	—
MOVEQ	Long	4(1/0)	—	—	—
ORI	Byte, Word	8(2/0)	—	12(2/1) +	20(3/0)
	Long	16(3/0)	—	20(3/2) +	—
SUBI	Byte, Word	8(2/0)	—	12(2/1) +	—
	Long	16(3/0)	—	20(3/2) +	—
SUBQ	Byte, Word	4(1/0)	8(1/0)*	8(1/1) +	—
	Long	8(1/0)	8(1/0)	12(1/2) +	—

+ add effective address calculation time
 * word only

Table 32 Single Operand Instruction Clock Periods

Instruction	Size	Register	Memory
CLR	Byte, Word	4(1/0)	8(1/1) +
	Long	6(1/0)	12(1/2) +
NBCD	Byte	6(1/0)	8(1/1) +
NEG	Byte, Word	4(1/0)	8(1/1) +
	Long	6(1/0)	12(1/2) +
NEGX	Byte, Word	4(1/0)	8(1/1) +
	Long	6(1/0)	12(1/2) +
NOT	Byte, Word	4(1/0)	8(1/1) +
	Long	6(1/0)	12(1/2) +
Scc	Byte, False	4(1/0)	8(1/1) +
	Byte, True	6(1/0)	8(1/1) +
TAS	Byte	4(1/0)	10(1/1) +
TST	Byte, Word	4(1/0)	4(1/0) +
	Long	4(1/0)	4(1/0) +

+ add effective address calculation time

● **SHIFT/ROTATE INSTRUCTION CLOCK PERIODS**

Table 33 indicates the number of clock periods for the shift and rotate instructions. The number of bus read and write cycles is shown in parenthesis as: (r/w). The number of clock periods and the number of read and write cycles must be added respectively to those of the effective address calculation where indicated.

● **BIT MANIPULATION INSTRUCTION CLOCK PERIODS**

Table 34 indicates the number of clock periods required for the bit manipulation instructions. The number of bus read and write cycles is shown in parenthesis as: (r/w). The number of clock periods and the number of read and write cycles must be added respectively to those of the effective address calculation where indicated.

● **CONDITIONAL INSTRUCTION CLOCK PERIODS**

Table 35 indicates the number of clock periods required for the conditional instructions. The number of bus read and write cycles is indicated in parenthesis as: (r/w). The number of clock periods and the number of read and write cycles must be added respectively to those of the effective address calculation where indicated.

● **JMP, JSR, LEA, PEA, MOVEM INSTRUCTION CLOCK PERIODS**

Table 36 indicates the number of clock periods required for the jump, jump to subroutine, load effective address, push effective address, and move multiple registers instructions. The number of bus read and write cycles is shown in parenthesis as: (r/w).

Table 33 Shift/Rotate Instruction Clock Periods

Instruction	Size	Register	Memory
ASR, ASL	Byte, Word	$6 + 2n(1/0)$	$8(1/1) +$
	Long	$8 + 2n(1/0)$	—
LSR, LSL	Byte, Word	$6 + 2n(1/0)$	$8(1/1) +$
	Long	$8 + 2n(1/0)$	—
ROR, ROL	Byte, Word	$6 + 2n(1/0)$	$8(1/1) +$
	Long	$8 + 2n(1/0)$	—
ROXR, ROXL	Byte, Word	$6 + 2n(1/0)$	$8(1/1) +$
	Long	$8 + 2n(1/0)$	—

Table 34 Bit Manipulation Instruction Clock Periods

Instruction	Size	Dynamic		Static	
		Register	Memory	Register	Memory
BCHG	Byte	—	$8(1/1) +$	—	$12(2/1) +$
	Long	$8(1/0) *$	—	$12(2/0) *$	—
BCLR	Byte	—	$8(1/1) +$	—	$12(2/1) +$
	Long	$10(1/0) *$	—	$14(2/0) *$	—
BSET	Byte	—	$8(1/1) +$	—	$12(2/1) +$
	Long	$8(1/0) *$	—	$12(2/0) *$	—
BTST	Byte	—	$4(1/0) +$	—	$8(2/0) +$
	Long	$6(1/0)$	—	$10(2/0)$	—

+ add effective address calculation time

* indicates maximum value

Table 35 Conditional Instruction Clock Periods

Instruction	Displacement	Trap or Branch Taken	Trap or Branch Not Taken
B _{CC}	Byte	$10(2/0)$	$8(1/0)$
	Word	$10(2/0)$	$12(2/0)$
BRA	Byte	$10(2/0)$	—
	Word	$10(2/0)$	—
BSR	Byte	$18(2/2)$	—
	Word	$18(2/2)$	—
DB _{CC}	CC _{true}	—	$12(2/0)$
	CC _{false}	$10(2/0)$	$14(3/0)$
CHK	—	$40(5/3) + *$	$10(1/0) +$
TRAP	—	$34(4/3)$	—
TRAPV	—	$34(5/3)$	$4(1/0)$

+ add effective address calculation time

* indicates maximum value

Table 36 JMP, JSR, LEA, PEA, MOMEM Instruction Clock Periods

Instr	Size	An@	An@ +	An@ -	An@(d)	An@(d, ix) *	xxx. W	xxx. L	PC@(d)	PC@(d, ix) *
JMP	—	8(2/0)	—	—	10(2/0)	14(3/0)	10(2/0)	12(3/0)	10(2/0)	14(3/0)
JSR	—	16(2/2)	—	—	18(2/2)	22(2/2)	18(2/2)	20(3/2)	18(2/2)	22(2/2)
LEA	—	4(1/0)	—	—	8(2/0)	12(2/0)	8(2/0)	12(3/0)	8(2/0)	12(2/0)
PEA	—	12(1/2)	—	—	16(2/2)	20(2/2)	16(2/2)	20(3/2)	16(2/2)	20(2/2)
MOVEM	Word	12+4n (3+n/0)	12+4n (3+n/0)	—	16+4n (4+n/0)	18+4n (4+n/0)	16+4n (4+n/0)	20+4n (5+n/0)	16+4n (4+n/0)	18+4n (4+n/0)
M → R	Long	12+8n (3+2n/0)	12+8n (3+2n/0)	—	16+8n (4+2n/0)	18+8n (4+2n/0)	16+8n (4+2n/0)	20+8n (5+2n/0)	16+8n (4+2n/0)	18+8n (4+2n/0)
MOVEM	Word	8+4n (2/n)	—	8+4n (2/n)	12+4n (3/n)	14+4n (3/n)	12+4n (3/n)	16+4n (4/n)	—	—
R → M	Long	8+8n (2/2n)	—	8+8n (2/2n)	12+8n (3/2n)	14+8n (3/2n)	12+8n (3/2n)	16+8n (4/2n)	—	—

n is the number of registers to move
 * is the size of the index register (ix) does not affect the instruction's execution time

● **MULTI-PRECISION INSTRUCTION CLOCK PERIODS**

Table 37 indicates the number of clock periods for the multi-precision instructions. The number of clock periods includes the time to fetch both operands, perform the operations, store

the results, and read the next instructions. The number of read and write cycles is shown in parenthesis as: (r/w).

In Table 37, the headings have the following meanings: Dn = data register operand and M = memory operand.

Table 37 Multi-Precision Instruction Clock Periods

Instruction	Size	op Dn, Dn	op M, M
ADDX	Byte, Word	4(1/0)	18(3/1)
	Long	8(1/0)	30(5/2)
CMPM	Byte, Word	—	12(3/0)
	Long	—	20(5/0)
SUBX	Byte, Word	4(1/0)	18(3/1)
	Long	8(1/0)	30(5/2)
ABCD	Byte	6(1/0)	18(3/1)
SBCD	Byte	6(1/0)	18(3/1)

● **MISCELLANEOUS INSTRUCTION CLOCK PERIODS**

Table 38 indicates the number of clock periods for the following miscellaneous instructions. The number of bus read and write cycles is shown in parenthesis as: (r/w). The number of clock periods plus the number of read and write cycles must be added to those of the effective address calculation where indicated.

● **EXCEPTION PROCESSING CLOCK PERIODS**

Table 39 indicates the number of clock periods for exception processing. The number of clock periods includes the time for all stacking, the vector fetch, and the fetch of the first instruction of the handler routine. The number of bus read and write cycles is shown in parenthesis as: (r/w).

Table 38 Miscellaneous Instruction Clock Periods

Instruction	Size	Register	Memory	Register → Memory	Memory → Register
MOVE from SR	—	6(1/0)	8(1/1) +	—	—
MOVE to CCR	—	12(2/0)	12(2/0) +	—	—
MOVE to SR	—	12(2/0)	12(2/0) +	—	—
MOVEP	Word	—	—	16(2/2)	16(4/0)
	Long	—	—	24(2/4)	24(6/0)
EXG	—	6(1/0)	—	—	—
EXT	Word	4(1/0)	—	—	—
	Long	4(1/0)	—	—	—
LINK	—	16(2/2)	—	—	—
MOVE from USP	—	4(1/0)	—	—	—
MOVE to USP	—	4(1/0)	—	—	—
NOP	—	4(1/0)	—	—	—
RESET	—	132(1/0)	—	—	—
RTE	—	20(5/0)	—	—	—
RTR	—	20(5/0)	—	—	—
RTS	—	16(4/0)	—	—	—
STOP	—	4(0/0)	—	—	—
SWAP	—	4(1/0)	—	—	—
UNLK	—	12(3/0)	—	—	—

+ add effective address calculation time

Table 39 Exception Processing Clock Periods

Exception	Periods
Reset	34(6/0)
Address Error	50(4/7)
Bus Error	50(4/7)
Interrupt	44(5/3)*
Illegal Instruction	34(4/3)
Privileged Violation	34(4/3)
Trace	34(4/3)

* The interrupt acknowledge bus cycle is assumed to take four external clock periods.

■ APPENDIX
● THE 68000S MASK SET

We implement the specification for HD68000-10/-12 and two corrections on the 68000S mask set. One of these corrections is the bus arbitration logic, and the other is a change to correct a RTE/RTR microcode problem.

(1) Bus Arbitration Logic

The problem occurs when bus grant acknowledge (\overline{BGACK}) is asserted for **only one clock cycle** while bus request (\overline{BR}) is negated. If \overline{BR} is asserted one clock cycle after \overline{BGACK} is negated, the processor asserts bus grant (\overline{BG}) and address strobe (\overline{AS}) at the same time (Refer to Figure 58). This, in

turn, may cause external DMA logic to run a bus cycle at the same time as the processor cycle, only when those particular timings are all satisfied. If the DMAC HD68450 is used, this problem can be avoided. Because the HD68450 negates \overline{BR} by one clock after the assertion of \overline{BGACK} .

For the 68000S mask set, an internal hardware change is implemented and a timing specification (t_{BGKBR}) is added.

If \overline{BR} and \overline{BGACK} meet the asynchronous set-up time t_{ASI} #47, then t_{BGKBR} can be ignored. If \overline{BR} and \overline{BGACK} are asserted asynchronously with respect to the clock, then \overline{BGACK} has to be asserted before \overline{BR} is negated.

Table 40 t_{BGKBR} Specification

Number	Item	Symbol	Test Condition	4MHz Version		6MHz Version		8MHz Version		10MHz Version		12.5MHz Version		Unit
				HD68000-4 HD68000Y4 HD68000Z4		HD68000-6 HD68000Y6 HD68000Z6		HD68000-8 HD68000Y8 HD68000Z8		HD68000-10 HD68000Y10 HD68000Z10		HD68000-12 HD68000Y12 HD68000Z12		
				min	max	min	max	min	max	min	max	min	max	
37A	BGACK "Low" to BR "High"	t _{BGKBR}	Fig. 57	30	-	25	-	20	-	20	-	20	-	ns

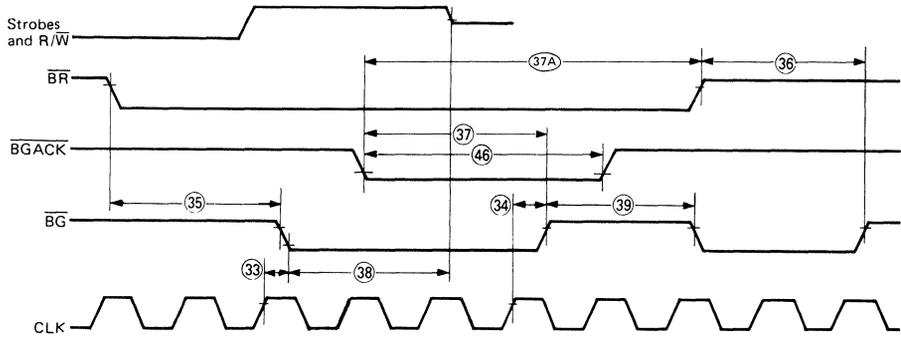


Figure 57 AC Electrical Waveforms – Bus Arbitration

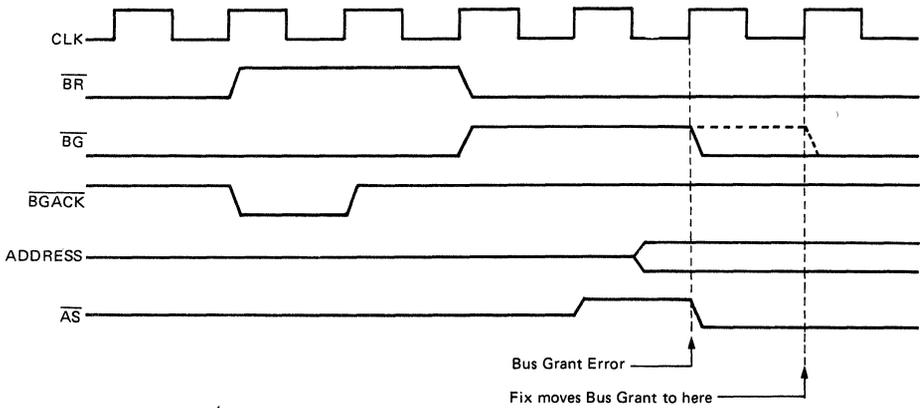
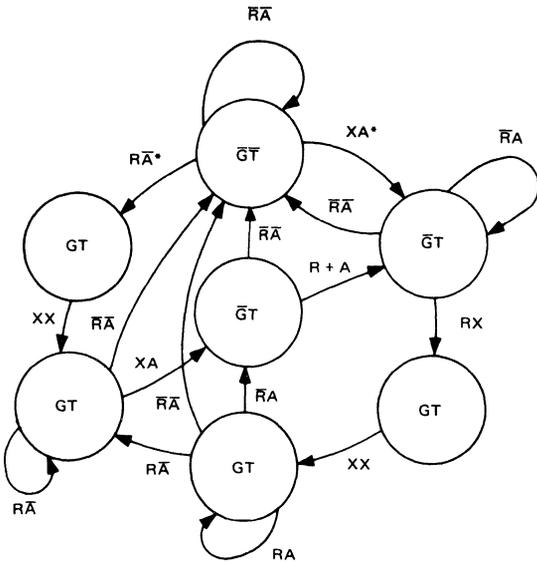


Figure 58 Bus Arbitration Timing Diagram Error Sequence

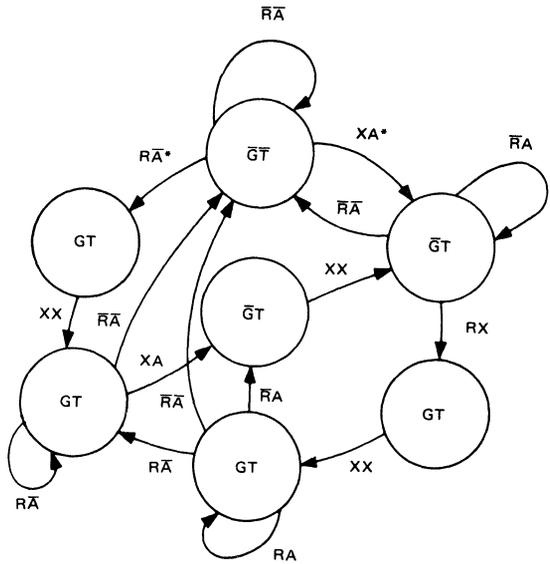
68000S Mask Set



R = Bus Request Internal
 A = Bus Grant Acknowledge Internal
 G = Bus Grant
 T = Three State Control to Bus Control Logic
 X = Don't Care

* State machine will not change state if bus is in S0. Refer to BUS ARBITRATION CONTROL for additional information.

68000R and 68000 Mask Set



R = Bus Request Internal
 A = Bus Grant Acknowledge Internal
 G = Bus Grant
 T = Three State Control to Bus Control Logic
 X = Don't Care

* State machine will not change state if bus is in S0. Refer to BUS ARBITRATION CONTROL for additional information.

Figure 59 State Diagram of HD68000 Bus Arbitration Unit

To Avoid this problem on 68000R mask set, users are recommended to choose one of the followings.

- 1) Negate \overline{BR} more than one clock after the assertion of \overline{BGACK} .
 - 2) Avoid the assertion of \overline{BGACK} for one clock cycle.
 - 3) Reassert \overline{BR} more than two clocks later than the negation of \overline{BGACK} .
 - 4) Use HD68450 as DMA controllers.
- (2) RTE/RTR Microcode Problem
 The error in the microcode only affects the RTR and the

RTE instructions. These two instructions execute correctly provided there is no bus error.

If there is a bus error on the 2nd, 3rd, or 4th bus cycle of RTR or RTE, the program counter is lost. The program counter loads the stack pointer +2 which is the same address as the access. The results is the program counter containing the stack pointer. This problem can occur on all HD68000 mask sets previous to 68000S.

The fix inhibits the loading of the program counter during this instruction until the 4th bus cycle.

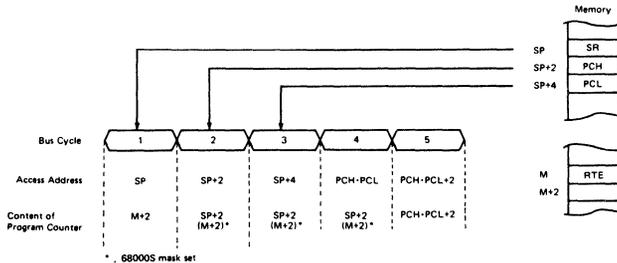


Figure 60 RTE Instruction Bus Cycle

HD68450, HD68450 Y DMAC (Direct Memory Access Controller)

Microprocessor implemented systems are becoming increasingly complex, particularly with the advent of high-performance 16-bit MPU devices with large memory addressing capability. In order to maintain high throughput, large blocks of data must be moved within these systems in a quick, efficient manner with minimum intervention by the MPU itself.

The HD68450 Direct Memory Access Controller (DMAC) is designed specifically to complement the performance and architectural capabilities of the HD68000 MPU by providing the following features:

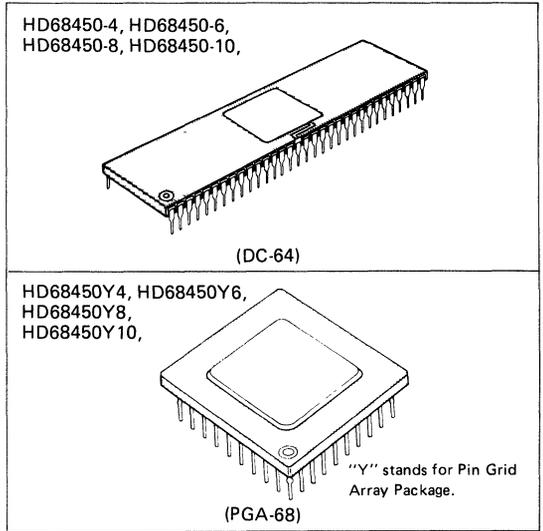
- HMCS68000 Bus Compatible
- 4 independent DMA Channels
- Memory-to-Memory, Memory-to-Device, Device-to-Memory Transfers
- MMU Compatible
- Array-Chained and Linked-Array-Chained Operations
- On-Chip Registers that allow Complete Software Control by the System MPU
- Interface Lines for Requesting, Acknowledging, and Incidental Control of the Peripheral Devices
- Variable System Bus Bandwidth Utilization
- Programmable Channel Prioritization
- 2 Vectored interrupts for each Channel
- Auto-Request and External-Request Transfer Modes
- +5 Volt Operation

The DMAC functions by transferring a series of operands (data) between memory and peripheral device; operand sizes can be byte, word, or long word. A block is a sequence of operations; the number of operands in a block is determined by a transfer count. A single-channel operation may involve the transfer of several blocks of data between memory and device.

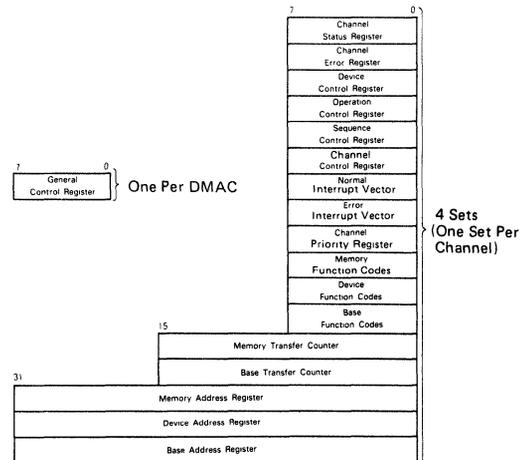
■ TYPE OF PRODUCTS

Type No.	Bus Timing	Packaging
HD68450-4	4MHz	DC-64
HD68450-6	6MHz	
HD68450-8	8MHz	
HD68450-10	10MHz	
HD68450Y4	4MHz	PGA-68
HD68450Y6	6MHz	
HD68450Y8	8MHz	
HD68450Y10	10MHz	

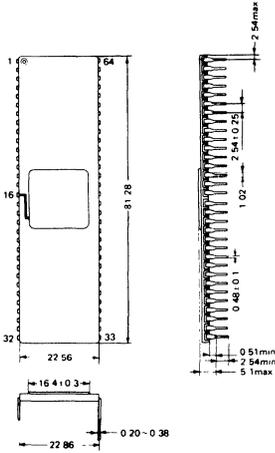
—The specifications for HD68450-10/-12 and HD68450Y10/Y12 are preliminary.—



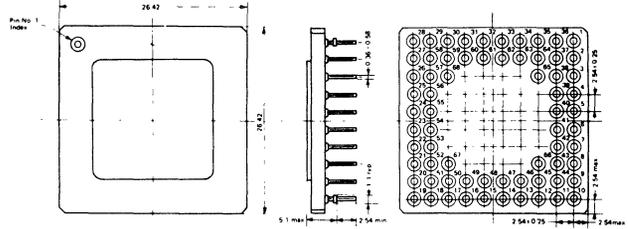
■ PROGRAMMING MODEL



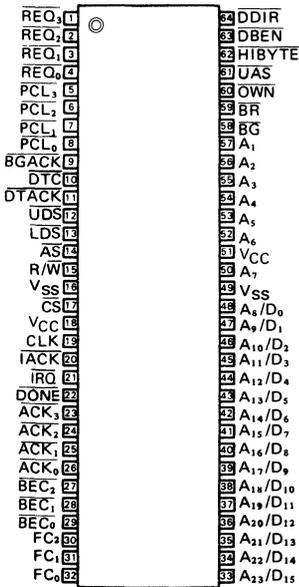
- PACKAGING INFORMATION (Dimensions in mm)
- DC-64 (SIDE-BRAZED CERAMIC DIP)



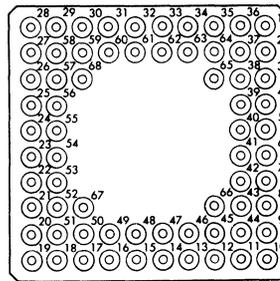
- PGA-68 (PIN GRID ARRAY PACKAGE)



- PIN ARRANGEMENT
- HD68450



- HD68450Y



Pin No.	Function	Pin No.	Function	Pin No.	Function	Pin No.	Function
1	N/C	18	PCL ₁	35	A ₁₉ /D ₁₁	52	BGACK
2	A ₁₃ /D ₅	19	DTACK	36	A ₁₇ /D ₉	53	LDS
3	A ₁₁ /D ₃	20	UDS	37	A ₁₅ /D ₇	54	VSS
4	A ₁₀ /D ₂	21	AS	38	A ₁₂ /D ₄	55	VCC
5	A ₉ /D ₀	22	R/W	39	A ₉ /D ₁	56	DONE
6	A ₇	23	N/C	40	VSS	57	IRO
7	A ₆	24	CS	41	VCC	58	ACK ₂
8	A ₅	25	CLK	42	A ₄	59	BEC ₂
9	A ₃	26	IACK	43	A ₂	60	BEC ₀
10	N/C	27	ACK ₅	44	BG	61	FC ₀
11	BR	28	ACK ₀	45	OWN	62	A ₂₁ /D ₁₃
12	UAS	29	BEC ₁	46	HIBYTE	63	A ₁₈ /D ₁₀
13	DBEN	30	FC ₂	47	DDIR	64	A ₁₆ /D ₈
14	REQ ₂	31	FC ₁	48	REQ ₁	65	A ₁₄ /D ₆
15	REQ ₂	32	A ₂₃ /D ₁₅	49	PCL ₂	66	A ₁
16	REQ ₀	33	A ₂₂ /D ₁₄	50	PCL ₀	67	DTC
17	PCL ₃	34	A ₂₀ /D ₁₂	51	N/C	68	ACK ₁

■ ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Value	Unit
Supply Voltage	V_{CC}^*	-0.3 ~ +7.0	V
Input Voltage	V_{in}^*	-0.3 ~ +7.0	V
Operating Temperature Range	T_{opr}	0 ~ +70	°C
Storage Temperature	T_{stg}	-55 ~ +150	°C

* With respect to V_{SS} (SYSTEM GND)

(NOTE) Permanent LSI damage may occur if maximum ratings are exceeded. Normal operation should be under recommended operating conditions. If these conditions are exceeded, it could affect reliability of LSI.

■ RECOMMENDED OPERATING CONDITIONS

Item	Symbol	min	typ	max	Unit
Supply Voltage	V_{CC}^*	4.75	5.0	5.25	V
Input Voltage	V_{IH}^*	2.0	—	V_{CC}	V
	V_{IL}^*	-0.3	—	0.8	V
Operating Temperature	T_{opr}	0	25	70	°C

* With respect to V_{SS} (SYSTEM GND)

■ ELECTRICAL CHARACTERISTICS

● DC CHARACTERISTICS ($V_{CC} = 5V \pm 5\%$, $V_{SS} = 0V$, $T_a = 0 \sim +70^\circ C$, unless otherwise noted.)

Item	Symbol	Test Condition	min	typ	max	Unit
Input "High" Voltage	V_{IH}		2.0	—	V_{CC}	V
Input "Low" Voltage	V_{IL}		$V_{SS} - 0.3$	—	0.8	V
Input Leakage Current	I_{in}	CS, IACK, BG, CLK, BEC ₀ ~ BEC ₂ REQ ₀ ~ REQ ₃	—	—	10	μA
Three-State (Off State) Input Current	I_{TSI}	A ₁ ~ A ₇ , D ₀ ~ D ₁₅ /A ₈ ~ A ₂₃ , AS, UDS, LDS, R/W, UAS, DTACK, BGACK, OWN, DTC, HIBYTE, DDIR, DBEN, FC ₀ ~ FC ₂	—	—	10	μA
Open Drain (Off State) Input Current	I_{ODI}	IREQ, DONE	—	—	20	μA
Output "High" Voltage	V_{OH}	A ₁ ~ A ₇ , D ₀ ~ D ₁₅ /A ₈ ~ A ₂₃ , AS, UDS, LDS, R/W, UAS, DTACK, BGACK, BR, OWN, DTC, HIBYTE, DDIR, DBEN, ACK ₀ ~ ACK ₃ , PCL ₀ ~ PCL ₃ , FC ₀ ~ FC ₂	$I_{OH} = -400 \mu A$	2.4	—	V
Output "Low" Voltage	V_{OL}	A ₁ ~ A ₇ , FC ₀ ~ FC ₂	$I_{OL} = 3.2 \text{ mA}$	—	—	0.5
	V_{OL}	D ₀ ~ D ₁₅ /A ₈ ~ A ₂₃ , AS, UDS, LDS, R/W, DTACK, BR, OWN, DTC, HIBYTE, DDIR, DBEN, ACK ₀ ~ ACK ₃ , UAS, PCL ₀ ~ PCL ₃ , BGACK	$I_{OL} = 5.3 \text{ mA}$	—	—	0.5
	V_{OL}	IRQ, DONE	$I_{OL} = 8.9 \text{ mA}$	—	—	0.5
Power Dissipation	P_D	$f = 8 \text{ MHz}, V_{CC} = 5.0 \text{ V}$ $T_a = 25^\circ C$	—	1.4	2.0	W
Capacitance	C_{in}	$V_{in} = 0V$, $T_a = 25^\circ C$, $f = 1 \text{ MHz}$	—	—	15	pF

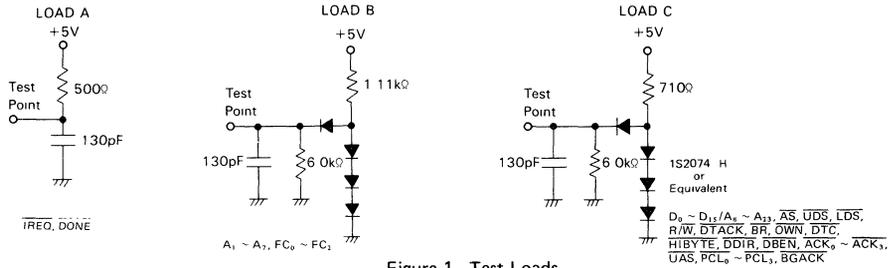


Figure 1 Test Loads

● AC ELECTRICAL SPECIFICATIONS (V_{CC} = 5V ±5%, V_{SS} = 0V, T_a = 0~+70°C)

No.	Item	Symbol	Test Condition	4MHz HD68450-4 HD68450Y4		6MHz HD68450-6 HD68450Y6		8MHz HD68450-8 HD68450Y8		10MHz* HD68450-10 HD68450Y10		Unit
				min	max	min	max	min	max	min	max	
	Frequency of Operation	f		2	4	2	6	2	8	2	10	MHz
1	Clock Period	t _{cyc}		250	500	167	500	125	500	100	500	ns
2	Clock Width Low	t _{CL}		115	250	75	250	55	250	45	250	ns
3	Clock Width High	t _{CH}		115	250	75	250	55	250	45	250	ns
4	Clock Fall Time	t _{cf}		-	10	-	10	-	10	-	10	ns
5	Clock Rise Time	t _{cr}		-	10	-	10	-	10	-	10	ns
6	Asynchronous Input Setup Time	t _{ASI}		30	-	25	-	20	-	15	-	ns
7	Data in to DBEN Low	t _{DI}		0	-	0	-	0	-	0	-	ns
8	DTACK Low to Data Invalid	t _{DTL}		0	-	0	-	0	-	0	-	ns
9	Address in to AS in Low	t _{AISL}		0	-	0	-	0	-	0	-	ns
10	AS, DS in High to Address in Invalid	t _{SIHAI}		0	-	0	-	0	-	0	-	ns
11	Clock High to DDIR Low	t _{CHDL}		-	90	-	80	-	70	-	60	ns
12	Clock High to DDIR High	t _{CHDH}		-	90	-	80	-	70	-	60	ns
13	DS in High to DDIR High Impedance	t _{DSHDZ}		-	160	-	140	-	120	-	110	ns
14	Clock Low to DBEN Low	t _{CLDL}		-	90	-	80	-	70	-	60	ns
15	Clock Low to DBEN High	t _{CLDH}		-	90	-	80	-	70	-	60	ns
16	DS in High to DBEN High Impedance	t _{DSHDBZ}		-	160	-	140	-	120	-	110	ns
17	Clock High to Data Out Valid (MPU read)	t _{CHDVM}		-	290	-	230	-	180	-	160	ns
18	DS in High to Data Out Invalid	t _{DSHDZn}		0	-	0	-	0	-	0	-	ns
19	DS in High to Data High Impedance	t _{DSHDZ}		-	160	-	140	-	120	-	110	ns
20	Clock Low to DTACK Low	t _{CLDTL}		-	90	-	80	-	70	-	60	ns
21	DS in High to DTACK High	t _{DSHDTH}		-	160	-	130	-	110	-	110	ns
22	DTACK Width High	t _{DTH}		10	-	10	-	10	-	10	-	ns
23	DS in High to DTACK High Impedance	t _{DSHDTZ}		-	220	-	200	-	180	-	160	ns
24	DTACK Low to DS in High	t _{DTLDH}		0	-	0	-	0	-	0	-	ns
25	REQ Width Low	t _{REQL}		2.0	-	2.0	-	2.0	-	2.0	-	clk. per.
26	REQ Low to BR Low	t _{RELBRL}		500	-	334	-	250	-	200	-	ns
27	Clock High to BR Low	t _{CHBRL}		-	90	-	80	-	70	-	60	ns
28	Clock High to BR High	t _{CHBRH}		-	90	-	80	-	70	-	60	ns
29	BG Low to BGACK Low	t _{BGLBL}		4.5	-	4.5	-	4.5	-	4.5	-	clk per
30	BR Low to MPU Cycle End (AS in High)	t _{BRLASH}		0	-	0	-	0	-	0	-	ns
31	MPU Cycle End (AS in High) to BGACK Low	t _{ASHBL}		4.5	5.5	4.5	5.5	4.5	5.5	4.5	5.5	clk. per
32	REQ Low to BGACK Low	t _{REQLBL}		12.0	-	12.0	-	12.0	-	12.0	-	clk. per.
33	Clock High to BGACK High	t _{CHBL}		-	90	-	80	-	70	-	60	ns
34	Clock High to BGACK High	t _{CHBH}		-	90	-	80	-	70	-	60	ns
35	Clock Low to BGACK High Impedance	t _{CLBZ}		-	120	-	100	-	80	-	70	ns
36	Clock High to FC Valid	t _{CHFV}		-	140	-	120	-	100	-	90	ns
37	Clock High to Address Valid	t _{CHAV}		-	160	-	140	-	120	-	110	ns
38	Clock High to Address/FC/Data High Impedance	t _{CHAZx}		-	140	-	120	-	100	-	100	ns
39	Clock High to Address/FC/Data Invalid	t _{CHAZn}		0	-	0	-	0	-	0	-	ns
40	Clock Low to Address High Impedance	t _{CLAZ}		-	140	-	120	-	100	-	90	ns
41	Clock High to UAS Low	t _{CHUL}		-	90	-	80	-	70	-	60	ns
42	Clock High to UAS High	t _{CHUH}		-	90	-	80	-	70	-	60	ns
43	Clock Low to UAS High Impedance	t _{CLUZ}		-	120	-	100	-	80	-	70	ns
44	UAS High to Address Invalid	t _{UHAi}		50	-	40	-	30	-	20	-	ns
45	Clock High to AS, DS Low	t _{CHSL}		-	80	-	70	-	60	-	55	ns
46	Clock Low to DS Low (write)	t _{CLDSL}		-	80	-	70	-	60	-	55	ns
47	Clock Low to AS, DS High	t _{CLSH}		-	90	-	80	-	70	-	60	ns
48	Clock Low to AS, DS High Impedance	t _{CLSZ}		-	120	-	100	-	80	-	70	ns
49	AS Width Low	t _{ASL}		545	-	350	-	255	-	195	-	ns
50	DS Width Low	t _{DSL}		420	-	265	-	190	-	145	-	ns
51	AS, DS Width High	t _{SH}		285	-	180	-	150	-	105	-	ns
52	Address/FC Valid to AS, DS Low	t _{AVSL}		50	-	40	-	30	-	20	-	ns
53	AS, DS High to Address/FC/Data Invalid	t _{SHAZ}		50	-	40	-	30	-	20	-	ns
54	Clock High to R/W Low	t _{CHRL}		-	90	-	80	-	70	-	60	ns
55	Clock High to R/W High	t _{CHRH}		-	90	-	80	-	70	-	60	ns

* Preliminary

(continued)

No	Item	Symbol	Test Condition	4MHz HD68450-4 HD68450Y4		6MHz HD68450-6 HD68450Y6		8MHz HD68450-8 HD68450Y8		10MHz* HD68450-10 HD68450Y10		Unit
				min	max	min	max	min	max	min	max	
				56	Clock Low to R/W High Impedance	t _{CLRZ}	—	120	—	100	—	
57	Address/FC Valid to R/W Low	t _{AVRL}	100	—	40	—	20	—	10	—	ns	
58	R/W Low to DS Low (write)	t _{RLSL}	285	—	170	—	120	—	90	—	ns	
59	DS High to R/W High	t _{SHRH}	60	—	50	—	40	—	20	—	ns	
60	Clock Low to OWN Low	t _{CLOL}	—	90	—	80	—	70	—	60	ns	
61	Clock Low to OWN High	t _{CLOH}	—	90	—	80	—	70	—	60	ns	
62	Clock High to OWN High Impedance	t _{CHOZ}	—	120	—	100	—	80	—	70	ns	
63	OWN Low to BGACK Low	t _{OLBL}	50	—	40	—	30	—	20	—	ns	
64	BGACK High to OWN High	t _{BHOH}	50	—	40	—	30	—	20	—	ns	
65	OWN Low to UAS Low	t _{OLUL}	50	—	40	—	30	—	20	—	ns	
66	Clock High to ACK Low	t _{CHACL}	—	90	—	80	—	70	—	60	ns	
67	Clock Low to ACK Low	t _{CLACL}	—	90	—	80	—	70	—	60	ns	
68	Clock High to ACK High	t _{CHACH}	—	90	—	80	—	70	—	60	ns	
69	ACK Low to DS Low	t _{ACLDSL}	230	—	140	—	100	—	80	—	ns	
70	DS High to ACK High	t _{DSHACH}	50	—	40	—	30	—	20	—	ns	
71	Clock High to HIBYTE Low	t _{CHHIL}	—	90	—	80	—	70	—	60	ns	
72	Clock Low to HIBYTE Low	t _{CLHIL}	—	90	—	80	—	70	—	60	ns	
73	Clock High to HIBYTE High	t _{CHHILH}	—	90	—	80	—	70	—	60	ns	
74	Clock Low to HIBYTE High Impedance	t _{CLHIZ}	—	120	—	100	—	80	—	70	ns	
75	Clock High to DTC Low	t _{CHDTL}	—	90	—	80	—	70	—	60	ns	
76	Clock High to DTC High	t _{CHDTH}	—	90	—	80	—	70	—	60	ns	
77	Clock Low to DTC High Impedance	t _{CLDTZ}	—	120	—	100	—	80	—	70	ns	
78	DTC Width Low	t _{DTCL}	230	—	147	—	105	—	80	—	ns	
79	DTC Low to DS High	t _{DTLDH}	95	—	50	—	30	—	20	—	ns	
80	Clock High to DONE Low	t _{CHDOL}	—	90	—	80	—	70	—	60	ns	
81	Clock Low to DONE Low	t _{CLDOL}	—	90	—	80	—	70	—	60	ns	
82	Clock High to DONE High	t _{CHDOH}	—	150	—	140	—	130	—	120	ns	
83	Clock Low to DDIR High Impedance	t _{CLDRZ}	—	120	—	100	—	80	—	70	ns	
84	Clock Low to DBEN High Impedance	t _{CLDRZ}	—	120	—	100	—	80	—	70	ns	
85	DDIR Low to DBEN Low	t _{DRLDBL}	50	—	40	—	30	—	20	—	ns	
86	DBEN High to DDIR High	t _{DBHDRH}	50	—	40	—	30	—	20	—	ns	
87	DBEN Low to Address/Data High Impedance	t _{DBLAZ}	—	17	—	17	—	17	—	17	ns	
88	Clock Low to PCL Low (1/8 clock)	t _{CLPL}	—	90	—	80	—	70	—	60	ns	
89	Clock Low to PCL High (1/8 clock)	t _{CLPH}	—	90	—	80	—	70	—	60	ns	
90	PCL Width Low (1/8 clock)	t _{PCLL}	4.0	—	4.0	—	4.0	—	4.0	—	clk per	
91	DTACK Low to Data In (setup time)	t _{DALDI}	—	320	—	200	—	150	—	115	ns	
92	DS High to Data Invalid (hold time)	t _{SHDI}	0	—	0	—	0	—	0	—	ns	
93	DS High to DTACK High	t _{SHDAH}	0	240	0	160	0	120	0	90	ns	
94	Data Out Valid to DS Low	t _{DOSL}	0	—	0	—	0	—	0	—	ns	
95	Data In to Clock Low (setup time)	t _{DICL}	30	—	25	—	15	—	15	—	ns	
96	BEC Low to DTACK Low	t _{BECDAL}	50	—	50	—	50	—	50	—	ns	
97	BEC Width Low	t _{BECL}	2.0	—	2.0	—	2.0	—	2.0	—	clk per.	
98	Clock High to IRQ Low	t _{CHIRL}	—	90	—	80	—	70	—	60	ns	
99	Clock High to IRQ High	t _{CHIRH}	—	150	—	140	—	130	—	120	ns	
100	READY In to DTC Low (Read)	t _{RALDTL}	270	—	180	—	145	—	120	—	ns	
101	READY In to DS Low (Write)	t _{RALDSL}	395	—	240	—	205	—	170	—	ns	
102	DS High to READY High	t _{DSHRAH}	0	240	0	160	0	120	0	90	ns	
103	DONE In Low to DTACK Low	t _{DOLDAL}	50	—	50	—	50	—	50	—	ns	
104	DS High to DONE In High	t _{DSHDOH}	0	240	0	160	0	120	0	90	ns	
105	Asynchronous Input Hold Time	t _{ASIH}	15	—	15	—	15	—	15	—	ns	

Fig. 1 ~ Fig. 8

* Preliminary

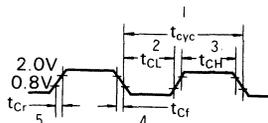


Figure 2 Input Clock Waveform

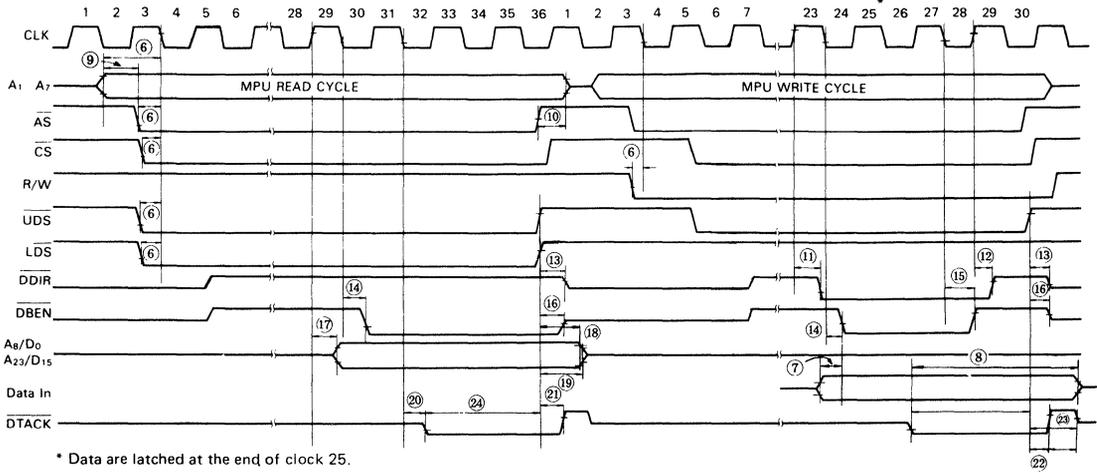


Figure 3 AC Electrical Waveforms – MPU Read/Write

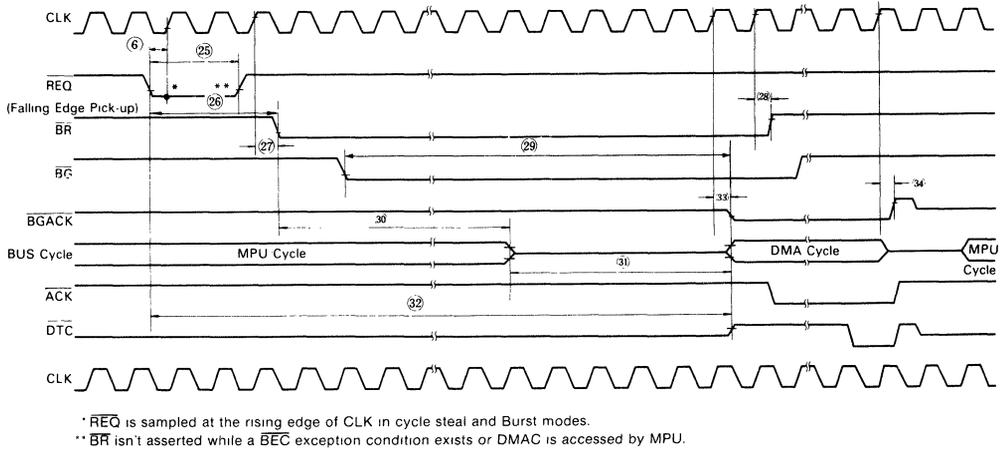
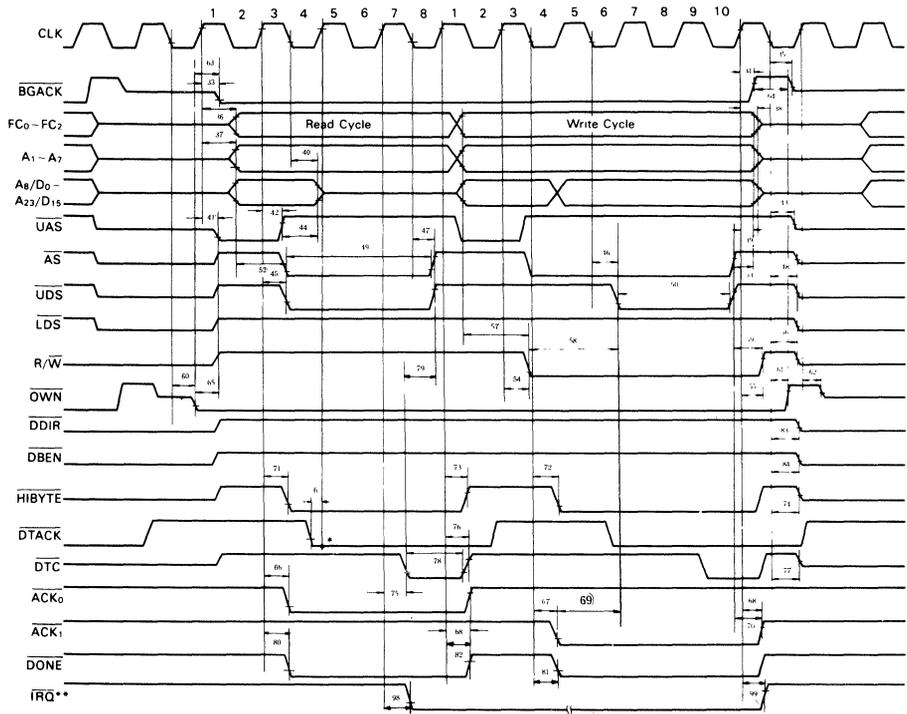
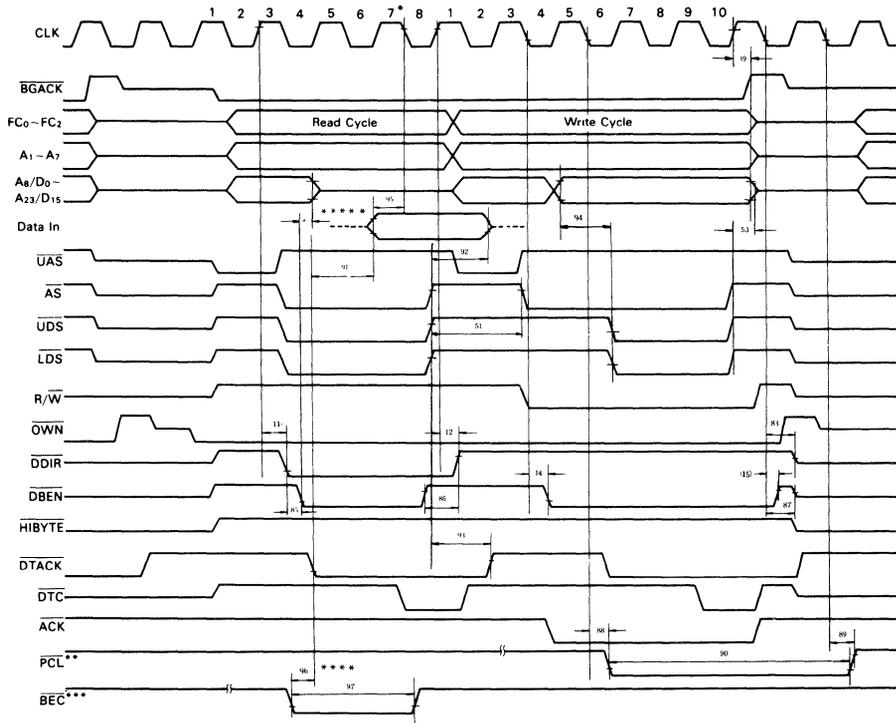


Figure 4 AC Electrical Waveforms – Bus Arbitration



* DTACK is sampled at the rising edge of CLK. This is different from HD68000.
 ** This timing is not related to DMA Read/Write (Single Cycle) sequencé

Figure 5 AC Electrical Waveforms – DMA Read/Write (Single Cycle)



- * Data is latched at the end of clock 7. This timing is the same as HD68000
- ** This timing is not related to DMA Read/Write (Dual Cycle) sequence. This timing is only applicable when 1/8 clock pulse mode is selected
- *** This timing is applicable when a bus exception occurs
- **** If #6 is satisfied for both DTACK and BEC, #96 may be On's
- ***** If the propagation delay of the external bidirectional buffer LS245 is less than 17nsec, a conflict may occur between the address output of the DMAC and the system data bus. In this case, the output of DBEN must be delayed externally

Figure 6 AC Electrical Waveforms – DMA Read/Write (Dual Cycle)

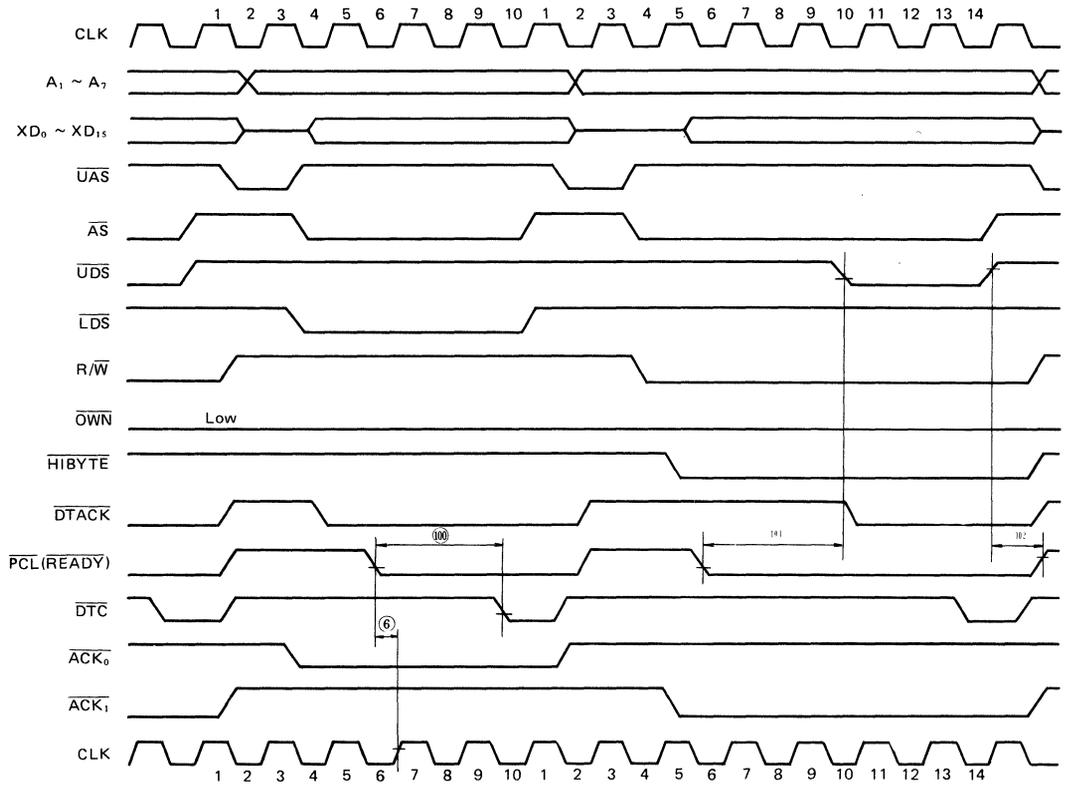
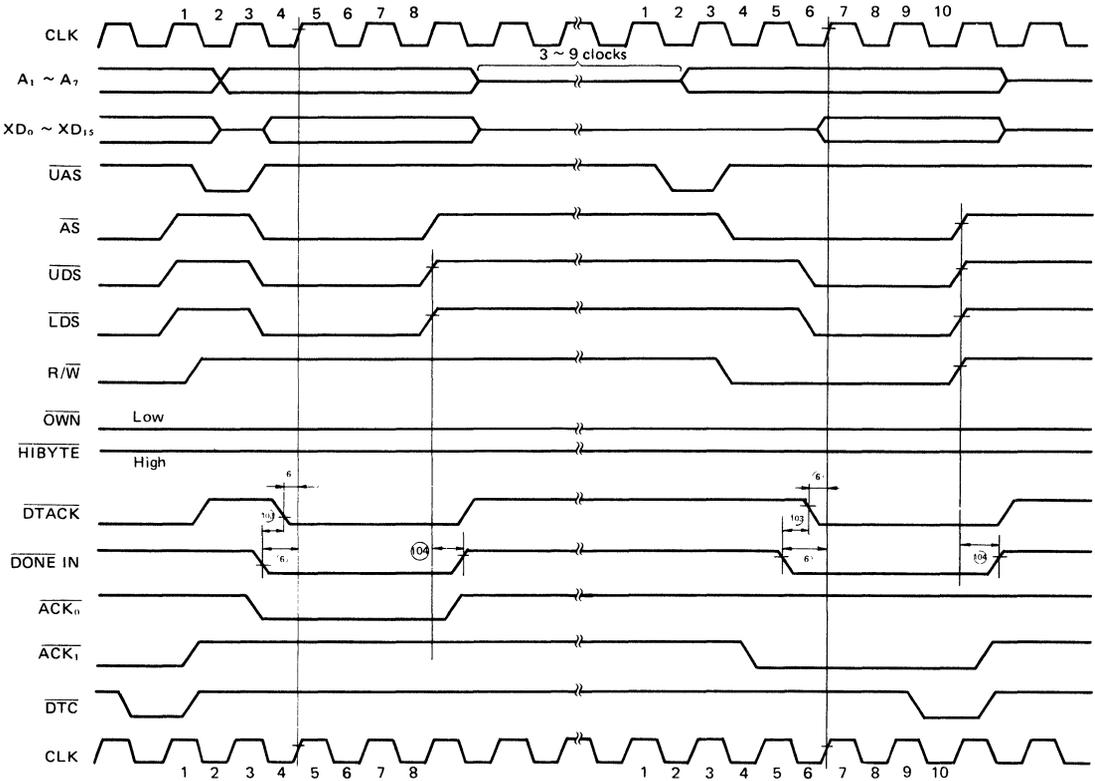


Figure 7 AC Electrical Waveforms – DMA Read/Write (Single Cycle with PCL)



* If #6 is satisfied for both DTACK and DONE, #103 may be 0ns.

Figure 8 AC Electrical Waveforms – DONE Input

(NOTES for Figure 3 through 8)

- 1) Setup time for the asynchronous inputs \overline{BG} , \overline{BGACK} , \overline{CS} , \overline{IACK} , \overline{AS} , \overline{UDS} , \overline{LDS} , and R/\overline{W} guarantees their recognition at the next falling edge of the clock. Setup time for $\overline{BEC}_0 \sim \overline{BEC}_7$, $\overline{REQ}_0 \sim \overline{REQ}_3$, $\overline{PCL}_0 \sim \overline{PCL}_3$, \overline{DTACK} , and \overline{DONE} guarantees their recognition at the next rising edge of the clock.
- 2) Timing measurements are referenced to and from a low voltage of 0.8 volts and a high voltage of 2.0 volts.
- 3) These waveforms should only be referenced in regard to the edge-to-edge measurement of the timing specifications. They are not intended as a functional description of the input and output signals. Refer to other functional descriptions and their related diagrams for device operation.

■ SIGNAL DESCRIPTION

The following section identifies the signals used in the DMAC. In the definitions, "MPU mode" refers to the state when the DMAC is chip selected by MPU. The term "DMA mode" refers to the state when the DMAC assumes ownership of the bus. The DMAC is in the "IDLE mode" at all other times. Moreover, the DMA bus cycle refers to the bus cycle that is executed by the DMAC in the "DMA mode".

NOTE) In this data sheet, the state of the signals is described with these words: active or assert, inactive or negate.

This is done to avoid confusion when dealing with a mixture of "active-low" and "active-high" signals. The term assert or assertion is used to indicate that a signal is active or true independent of whether that voltage is low or high. The term negate or negation is used to indicate that a signal is inactive or false.

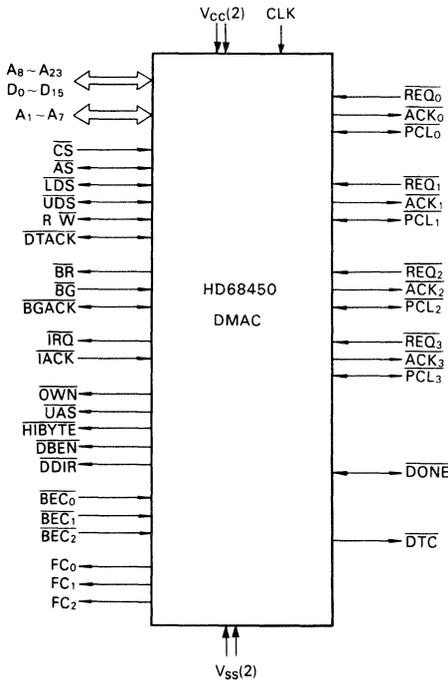


Figure 9 Input and Output Signals

● Address/Data Bus (A₈/D₀ through A₂₃/D₁₅)

Input/Output Active-high	Three-statable
-----------------------------	----------------

These lines are time multiplexed for the address and data bus. The lines \overline{DDIR} , \overline{DBEN} , \overline{UAS} and \overline{OWN} are used to control the demultiplexing of the data and address lines externally. Demultiplexing is explained in a later section. The bi-directional data bus is used to transfer data between DMAC, MPU, memory and I/O devices.

Address lines are outputs to address memory and I/O devices.

● Address Bus (A₁ through A₇)

Input/Output Active-high	Three-statable
-----------------------------	----------------

In the MPU mode, the DMAC internal registers are accessed with these lines and \overline{LDS} , \overline{UDS} . The address map for these registers is shown in Table 1. During a DMA bus cycle, A₁-A₇ are outputs containing the low order address bits of the location being accessed.

● Function Code (FC₀ through FC₂)

Output Active-high	Three-statable
-----------------------	----------------

These output signals provide the function codes during DMA bus cycles. They are three-stated except in the DMA bus cycles. They are used to control the HMCS68000 memories.

● Clock (CLK)

Input	
-------	--

This is the input clock to the HD68450, and should never be terminated at any time. This clock can be different from the MPU clock since HD68450 operates completely asynchronously.

● Chip Select (\overline{CS})

Input Active low	
---------------------	--

This input signal is used to chip select the DMAC in "MPU" mode. If the \overline{CS} input is asserted during a bus cycle which is generated by the DMAC, the DMAC internally terminates the bus cycle and signals an address error. This function protects the DMAC from accessing its own register.

● Address Strobe (\overline{AS})

Input/Output Active low	Three-statable
----------------------------	----------------

In the "MPU mode," this line is an input indicating valid address input, and during the DMA bus cycle it is an output indicating a valid address output from the DMAC on the address bus.

The DMAC monitors these input lines during bus arbitration to determine the completion of the bus cycle by the MPU or other bus masters.

● Upper Address Strobe (\overline{UAS})

Output Active low	Three-statable
----------------------	----------------

This line is an output to latch the upper address lines on the multiplexed data/address lines. It is three-stated except in the "DMA mode".

● Own (\overline{OWN})

Output Active low	Three-statable
----------------------	----------------

This line is asserted by the DMAC during DMA mode, and is used to control the output of the address line latch. This line may also be used to control the direction of bi-directional buffers when loads on \overline{AS} , \overline{LDS} , \overline{UDS} , R/\overline{W} and other signals exceed the drive capability. It is three-stated in the "MPU mode" and the "IDLE mode"

• **Data Direction (\overline{DDR})**

Outputs	Three-statable
Active low (when data direction is input to the DMAC)	
Active high (when the data direction is output from the DMAC)	

This line controls the direction of data through the bidirectional buffer which used to demultiplex the data/address lines. It is three-stated during the "IDLE mode"

• **Data Bus Enable (\overline{DBEN})**

Output	Three-statable
Active low	

This line controls the output enable line of bidirectional buffers on the multiplexed data/address lines. It is a three-stated during the "IDLE mode".

• **High Byte (\overline{HIBYTE})**

Output	Three-statable
Active low	

This line is used when the operand size is a byte in the single addressing mode. It is asserted when data is present on the upper eight bits of the data bus. It is used to control the output of the bidirectional buffers which connect the upper eight bits of the data bus with the lower eight bits. It is three-stated during the "MPU mode" and the "IDLE mode."

• **Read/Write (R/\overline{W})**

Input/Output	Three-statable
Active low (write)	
Active high (read)	

This line is an input in the "MPU mode" and an output during the "DMA mode". It is three-stated during the "IDLE mode". It is used to control the direction of data flow.

• **Upper Data Strobe (\overline{UDS}), Lower Data Strobe (\overline{LDS})**

Input/Output	Three-statable
Active low	

These lines are extensions of the address lines indicating which byte or bytes of the addressed word are being addressed. These lines combined corresponds to address line A_0 in table 1.

• **Data Transfer Acknowledge (\overline{DTACK})**

Input/Output	Three-statable
Active low	

In the "MPU mode", this line is an output indicating the completion of Read/Write bus cycle by the MPU.

In the "DMA mode", the DMAC monitors this line to determine when a data transfer has completed. In the event that a bus exception is requested, except for \overline{HALT} , prior to or concurrent with \overline{DTACK} , the \overline{DTACK} response is ignored and the bus exception is honored. In the "IDLE mode", this signal is three-stated.

• **Bus Exception Controls (\overline{BEC}_0 through \overline{BEC}_2)**

Input
Active low

These lines provide an encoded signal input indicating an exceptional condition in the DMA bus cycle. See bus exception section for details.

• **Bus Request (\overline{BR})**

Output
Active low

This output line is used to request ownership of the bus by the DMAC.

• **Bus Grant (\overline{BG})**

Input
Active low

This line is used to indicate to the DMAC that it is to be the next bus master. The DMAC cannot assume bus ownership until both \overline{AS} and \overline{BGACK} becomes inactive. Once the DMAC acquires the bus, it does not continue to monitor the \overline{BG} input.

• **Bus Grant Acknowledge (\overline{BGACK})**

Input/Output	Three-statable
Active low	

Bus Grant Acknowledge (\overline{BGACK}) is a bidirectional control line. As an output, it is generated by the DMAC to indicate that it is the bus master.

As an input, \overline{BGACK} is monitored by the DMAC, in limited rate auto-request mode, to determine whether or not the current bus master is a DMA device or not. \overline{BGACK} is also monitored during bus arbitration in order to assume bus ownership.

• **Interrupt Request (\overline{IRQ})**

Output	Open drain
Active low	

This line is used to request an interrupt to the MPU.

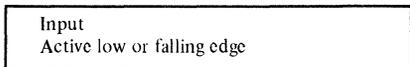
• **Interrupt Acknowledge (\overline{IACK})**

Input
Active low

This line is an input to the DMAC indicating that the current bus cycle is an interrupt acknowledge cycle by the MPU. The

DMAC responds the interrupt vector of the channel with the highest priority requesting an interrupt. There are two kinds of the interrupt vectors for each channel: normal (NIV) or error (EIV). IACK is not serviced if the DMAC has not generated IRQ.

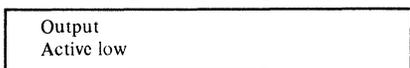
● Channel Request (\overline{REQ}_0 through \overline{REQ}_3)



These lines are the DMA transfer request inputs from the peripheral devices.

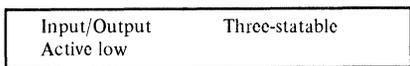
These lines are falling edge sensitive inputs when the request mode is cycle steal. They are low-level sensitive when the request mode is burst.

● Channel Acknowledge (\overline{ACK}_0 through \overline{ACK}_3)



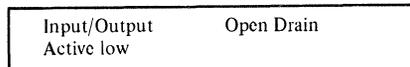
These lines indicate to the I/O device requesting a transfer that the request is acknowledged and the transfer is to be performed. These lines may be used as a part of the enable circuit for bus interface to the peripheral.

● Peripheral Control Line (\overline{PCL}_0 through \overline{PCL}_3)



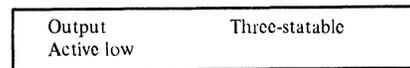
The four lines ($\overline{PCL}_0 \sim \overline{PCL}_3$) are multi-purpose lines which may be individually programmed to be a START output, an Enable Clock input, a READY input, an ABORT input, a STATUS input, or an INTERRUPT input.

● Done (\overline{DONE})



As an output, this line is asserted concurrently with the \overline{ACK}_X timing to indicate the last data transfer to the peripheral device. As an input, it allows the peripheral device to request a normal termination of the DMA transfer.

● Device Transfer Complete (\overline{DTC})



This line is asserted when the DMA bus cycle has terminated normally with no exceptions. It may be used to supply the data latch timing to the peripheral device. In this case, data is valid at the falling edge of \overline{DTC} .

■ INTERNAL ORGANIZATION

The DMAC has four independent DMA channels. Each channel has its own set of channel registers. These registers define and control the activity of the DMAC in processing a channel operation.

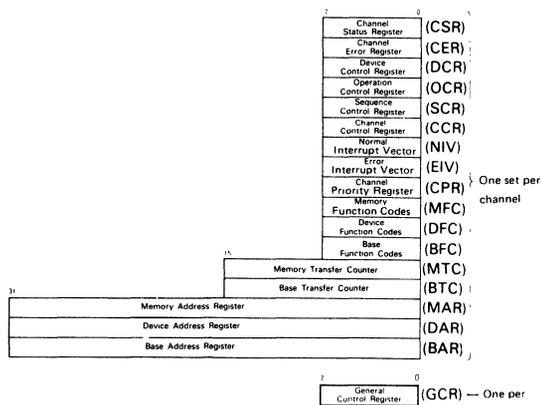


Figure 10 Internal Registers

● Register Organization

The internal register addresses are represented in Table 1. Address space not used within the address map is reserved for future expansion. A read from an unused location in the map results in a normal bus cycle with all ones for data. A write to one of these locations results in a normal bus cycle but no write occurs.

Unused bits of the defined registers in Table 1 read as zeros.

Table 1 Internal Register Addressing Assignments

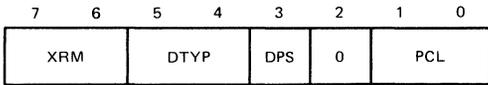
Register	Address Bits							Mode		
	7	6	5	4	3	2	1		0	
Channel Status Register	c	c	0	0	0	0	0	0	R	W*
Channel Error Register	c	c	0	0	0	0	0	1	R	
Device Control Register	c	c	0	0	1	0	0	R	W	
Operation Control Register	c	c	0	0	1	0	1	R	W	
Sequence Control Register	c	c	0	0	0	1	0	R	W	
Channel Control Register	c	c	0	0	0	1	1	R	W	
Memory Transfer Counter	c	c	0	0	1	0	1	b	R	W
Memory Address Register	c	c	0	0	1	1	s	R	W	
Device Address Register	c	c	0	1	0	1	s	R	W	
Base Transfer Counter	c	c	0	1	1	0	1	b	R	W
Base Address Register	c	c	0	1	1	1	s	R	W	
Normal Interrupt Vector	c	c	1	0	0	1	0	1	R	W
Error Interrupt Vector	c	c	1	0	0	1	1	1	R	W
Channel Priority Register	c	c	1	0	1	0	1	R	W	
Memory Function Codes	c	c	1	0	0	0	1	R	W	
Device Function Codes	c	c	1	1	0	0	0	1	R	W
Base Function Codes	c	c	1	1	0	0	1	R	W	
General Control Register	1	1	1	1	1	1	1	R	W	

cc:00-Channel ≠ 0,01-Channel ≠ 1,
10-Channel ≠ 2,11-Channel ≠ 3,
ss:00-high-order, 01-upper middle,
10-lower middle,11-low-order
b:0-high-order, 1-low-order
* see Channel Status Register Section

● Device Control Register (DCR)

The DCR is a device oriented control register. The XRM bits specifies whether the channel is in burst or cycle steal request mode. The DTYP bits define what type of device is on the channel. If the DTYP bits are programmed to be a HMCS6800 device, the PCL definition is ignored and the PCL line is an Enable clock input. If the DTYP bits are programmed to be a device with \overline{READY} , the PCL definition is ignored and the PCL line is a \overline{READY} input. The DPS bit defines the port size (eight or sixteen bits) of the peripheral device. (A port size is the largest data which the peripheral device can transfer during a DMA bus cycle.) The PCL bits define the function of the PCL line. If the DTYP bits are programmed to be HMCS6800 device, or Device with \overline{ACK} and \overline{READY} , these definitions are ignored. The XRM

bits are ignored if an auto-request mode (REQG = 00 or 01 in Operation Control Register) is selected.



XRM (EXTERNAL REQUEST MODE)

- 00 Burst Transfer Mode
- 01 (undefined, reserved)
- 10 Cycle Steal Mode without Hold
- 11 Cycle Steal Mode with Hold

DTYP (DEVICE TYPE)

- 00 HD68000 compatible device, explicitly addressed (dual addressing mode)
- 01 HD68000 compatible device, explicitly addressed (dual addressing mode)
- 10 Device with \overline{ACK} , implicitly addressed (single addressing mode)
- 11 Device with \overline{ACK} and \overline{READY} , implicitly addressed (single addressing mode)

DPS (DEVICE PORT SIZE)

- 0 8 bit port
- 1 16 bit port

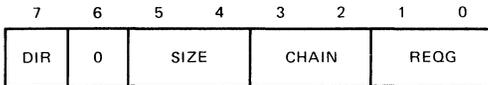
PCL (PERIPHERAL CONTROL LINE)

- 00 Status Input
- 01 Status Input with Interrupt
- 10 Start Pulse
- 11 Abort Input

Bit 2 Not Used

• **Operation Control Register (OCR)**

The OCR is an operation control register. The DIR bit defines the direction of the transfer. The SIZE bits define the size of the operand. The CHAIN bits define the type of the CHAIN mode. The REQG bits define how requests for transfers are generated.



DIR (DIRECTION)

- 0 Transfer from memory to device (transfer from MAR address to DAR address)
- 1 Transfer from device to memory (transfer from DAR address to MAR address)

SIZE (OPERAND SIZE)

- 00 Byte (8 bits)
- 01 Word (16 bits)
- 10 Long Word (32 bits)
- 11 (undefined, reserved)

CHAIN (CHAINING OPERATION)

- 00 Chain operation is disabled
- 01 (undefined, reserved)
- 10 Array Chaining
- 11 Linked Array Chaining

REQG (DMA REQUEST GENERATION METHOD)

- 00 Auto-request at transfer rate limited by General Control Register (Limited Rate Auto-Request)
- 01 Auto-request at maximum rate

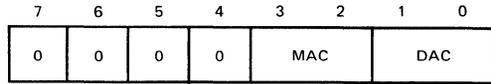
10 \overline{REQ} line requests an operand transfer

11 Auto-request the first operand, external request for subsequent operands

Bit 6 Not Used

• **Sequence Control Register (SCR)**

The SCR is used to define the sequencing of memory and device addresses.



MAC (MEMORY ADDRESS COUNT)

- 00 Memory address register does not count
- 01 Memory address register counts up
- 10 Memory address register counts down
- 11 (undefined, reserved)

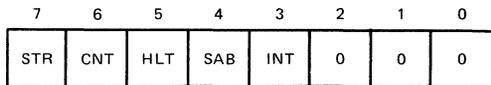
DAC (DEVICE ADDRESS COUNT)

- 00 Device address register does not count
- 01 Device address register counts up
- 10 Device address register counts down
- 11 (undefined, reserved)

Bits 7, 6, 5, 4 Not Used

• **Channel Control Register (CCR)**

The CCR is used to start or terminate the operation of a channel. This register also determines if an interrupt request is to be generated. Setting the STR bit causes immediate activation of the channel; the channel will be ready to accept request immediately. The STR and CNT bits of the register cannot be reset by a write to the register. The SAB bit is used to terminate the operation forcibly. Setting the SAB bit will reset STR and CNT. Setting the HLT bit will halt the channel operation, and clearing the HLT bit will resume the operation. Setting the start bit must be done by a byte access. Otherwise, a timing error occurs.



STR (START OPERATION)

- 0 No operation is pending
- 1 Start operation

CNT (CONTINUE OPERATION)

- 0 No continuation is pending
- 1 Continue operation

HLT (HALT OPERATION)

- 0 Operation not halted
- 1 Operation halted

SAB (SOFTWARE ABORT)

- 0 Channel operation not aborted
- 1 Abort channel operation

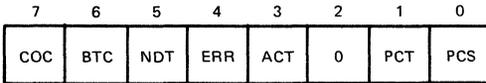
INT (INTERRUPT ENABLE)

- 0 No interrupts enabled
- 1 Interrupts enabled

Bits 2, 1, 0 Not Used

• **Channel Status Register (CSR)**

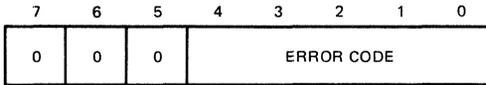
The CSR is a register containing the status of the channel.



- COC (CHANNEL OPERATION COMPLETE)**
0 Channel operation incomplete
1 Channel operation complete
 - BTC (BLOCK TRANSFER COMPLETE)**
0 Block transfer incomplete
1 Block transfer complete
 - NDT (NORMAL DEVICE TERMINATION)**
0 No normal device termination by DONE input
1 Device terminated operation normally by DONE input
 - ERR (ERROR BIT)**
0 No errors
1 Error as coded in CER
 - ACT (CHANNEL ACTIVE)**
0 Channel not active
1 Channel active
 - PCT (PCL TRANSITION)**
0 No PCL transition occurred
1 PCL transition occurred
 - PCS (THE STATE OF THE PCL INPUT LINE)**
0 PCL "Low"
1 PCL "High"
- Bit 2 Not Used

● **Channel Error Register (CER)**

The CER is an error condition status register. The ERR bit of CSR indicates if there is an error or not. Bits 0-4 indicate what type of error occurred.



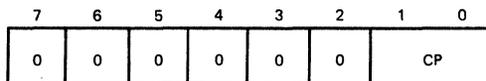
Error Code

- 00000 No error
- 00001 Configuration error
- 00010 Operation timing error
- 00101 Address error in MAR
- 00110 Address error in DAR
- 00111 Address error in BAR
- 01001 Bus error in MAR
- 01010 Bus error in DAR
- 01011 Bus error in BAR
- 01101 Count error in MTC
- 01111 Count error in BTC
- 10000 External abort
- 10001 Software abort

Bits 7, 6, 5 Not Used

● **Channel Priority Register (CPR)**

The CPR is used to define the priority level of the channel. Priority level 0 is the highest and priority level 3 is the lowest priority.

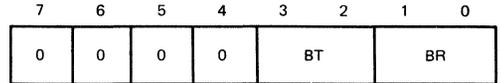


CP (CHANNEL PRIORITY)

- 00 Priority level 0
 - 01 Priority level 1
 - 10 Priority level 2
 - 11 Priority level 3
- Bit 7 through 2 Not Used

● **General Control Register (GCR)**

The GCR is used to define what portion of the bus cycles is available to the DMAC for limited rate auto-request generation. GCR is also used to specify the hold time for cycle steal mode with hold.



BT (BURST TIME)

The number of DMA clock cycles per burst that the DMAC allows in the auto-request at a limited rate of transfer is controlled by these two bits. The number is $2(BT+4)$ (two to the BT+4 power).

BR (BANDWIDTH RATIO)

The amount of the bandwidth utilized by the auto-request at a limited rate transfer is controlled by these two bits. The ratio is $2(BR+1)$ (two to the BR+1 power).

The hold time for cycle steal mode with hold is defined to be minimum of 1 sample interval and maximum of 2 sample intervals. A sample interval is defined to be $2(BT+BR+5)$ (two to the BT+BR+5 power) clock cycles.

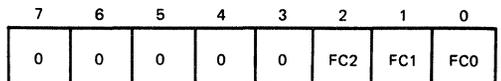
Bits 7 through 4 Not Used

● **Address Registers (MAR, DAR, BAR)**

Three 32-bit registers are utilized to implement the Memory Address Register, Device Address Register, and the Base Address Register. Only the least significant twenty-four bits are connected to the address output pins. The content of the MAR is outputted when the memory is accessed in single or dual addressing mode. The content of the DAR is outputted when the peripheral device is accessed. The contents of the BAR is outputted when reading chain information from memory in the Array Chaining Mode or the Linked Array Chaining Mode. It is also used to set the top address of the next block transfer in Continue mode.

● **Function Code Registers (MFC, DFC, BFC)**

The DMAC has three function code registers per channel: the Memory Function Code Register (MFC), Device Function Code Register (DFC), and the Base Function Code Register (BFC). The contents of these registers are outputted from FC₀ through FC₂ lines when an address is outputted from MAR, DAR, or BAR, respectively. The BFC is also used to set the MFC for the transfer of the next data block in the Continue mode.



Bits 3 through 7 Not Used

● **Transfer Count Registers (MTC, BTC)**

Each channel has two 16-bit counters: the Memory Transfer Counter (MTC) and the Base Transfer Counter (BTC). The MTC

counts the number of transfer words in one block, and is decreased by one for every operand transfer.

The BTC is used to count the number of data blocks in the Array Chaining Mode. BTC is also used to set the number of operands to transfer for the next data block in the Continue Mode.

● **Interrupt Vector Registers (NIV, EIV)**

Each channel has a Normal Interrupt Vector register and an Error Interrupt Vector register.

When an interrupt acknowledge cycle occurs, an interrupt vector is outputted from one of these registers. If the error bit (CSR) is set for the channel with interrupt pending, then content of EIV is outputted, otherwise content of NIV is outputted.

■ **OPERATION DESCRIPTION**

A DMAC channel operation proceeds in three principal phases. During the initialization phase, the MPU sets the channel control registers, supply the initial address and the number of transfer words, and starts the channel. During the transfer phase, the DMAC accepts requests for data operand transfers, and provides addressing and bus controls for the transfers. The termination phase occurs after the operation is completed.

This section describes DMAC operations. A description of the MPU/DMAC communication is given first. Next, the transfer phase is covered, including how the DMAC recognizes requests and how the DMAC arranges for data transfer. Following this, the initialization phase is described. The termination phase is covered, introducing chaining, error signaling, and bus exceptions. A description of the channel priority scheme rounds out the section.

● **Read/Write of the DMAC Registers by MPU**

The MPU reads and writes the DMAC internal registers and controls the DMA transfer. Figure 11 indicates the timing diagram when the MPU reads the contents of the DMAC register. The MPU outputs A_1-A_{23} , FC_0-FC_2 , \overline{AS} , R/\overline{W} , \overline{UDS} , and \overline{LDS} , and accesses the DMAC internal register. The specific internal register is selected by A_1-A_7 , \overline{LDS} and \overline{UDS} . The \overline{CS} and \overline{IACK} lines are generated by the external circuit with A_8-A_{23} and FC_0-FC_2 . The DMAC outputs data on the data bus, together with \overline{DDIR} , \overline{DBEN} and \overline{DTACK} . The \overline{DDIR} and \overline{DBEN} control the bidirectional buffer on the bus and the \overline{DTACK} indicates that the data has been sent or received by the DMAC. Read Cycle is eighteen CLKs. Figure 12 shows the MPU write cycle. Write cycle is fifteen CLKs.

Note the following points.

- (1) The clock reference shown in this figure is the DMAC input clock.
- (2) The \overline{DDIR} and the \overline{DBEN} are three-stated at the beginning which detects \overline{CS} and the ending of the cycle.
- (3) During the MPU read cycle, the \overline{DTACK} is asserted after the data is valid on the system bus.
- (4) During the MPU write cycle, the \overline{DDIR} line will be driven low to direct the data buffers toward to DMAC before the buffers are enabled.
- (5) During the MPU write cycle, the DMAC will latch the data before asserting \overline{DTACK} . Then it will negate \overline{DBEN} and \overline{DDIR} in the proper order.
- (6) After the MPU cycle and the \overline{LDS} and the \overline{UDS} are negated by the MPU, the DMAC will put \overline{DBEN} , \overline{DDIR} and the address data lines to a high impedance state.
- (7) \overline{DTACK} will once go "High" and then to a high impedance state after negating \overline{LDS} and \overline{UDS} .

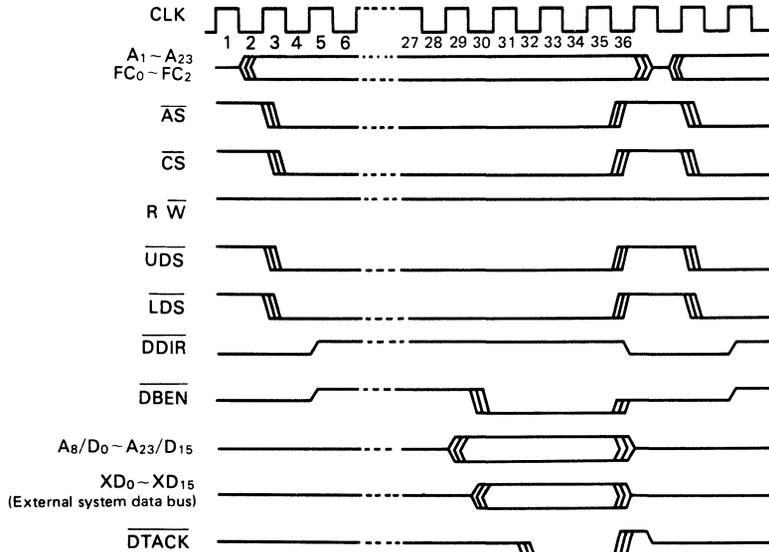


Figure 11 MPU Read from DMAC – Word

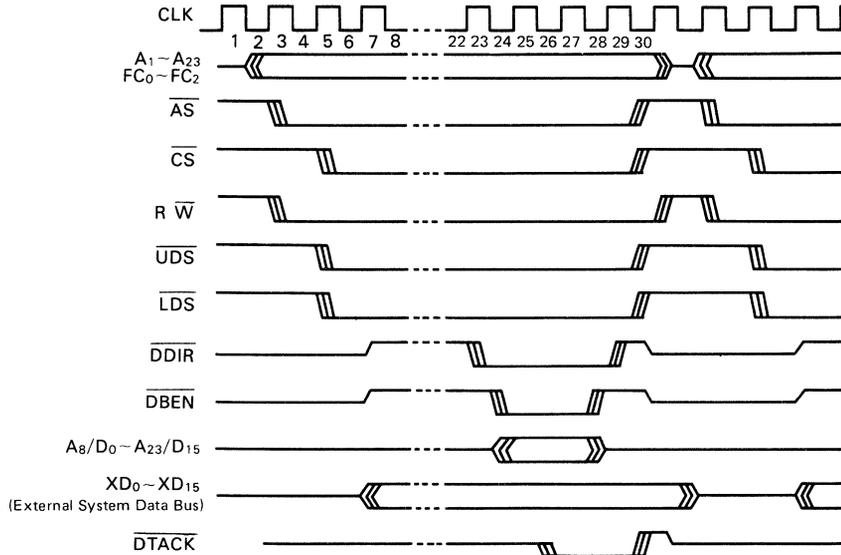
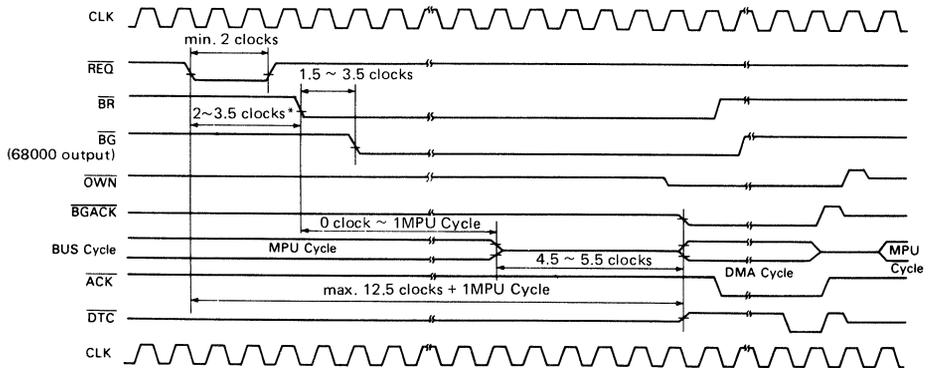


Figure 12 MPU Write to DMAC – Word

● Bus Arbitration

The DMAC must obtain ownership of the bus in order to transfer data. Figure 13 indicates the DMAC bus arbitration timing. It is completely compatible with that of HD68000 MPU. The DMAC asserts the Bus Request (\overline{BR}) to request the bus mastership. The MPU recognizes the request and asserts BG, then it grants the ownership in the next bus cycle. After the end of the current cycle

(\overline{AS} is negated), the MPU relinquishes the bus to the DMAC. The DMAC asserts the bus grant acknowledge (\overline{BGACK}) to indicate that it has the bus ownership. A half clock before \overline{BGACK} is asserted, the DMAC asserts \overline{OWN} . \overline{OWN} is kept asserted for a half clock after \overline{BGACK} is negated at the end of the DMA cycle. \overline{BR} is negated one clock after \overline{BGACK} is asserted.



* This case assumes that no exception condition exists and DMAC isn't accessed by MPU.

Figure 13 DMAC Bus Arbitration Timing

● **Device/DMAC Communication**

Communication between peripheral devices and the DMAC is accommodated by five signal lines. Each channel has REQ, ACK and PCL, and the last two lines the DONE and DTC lines, are shared among the four channels.

(1) **Request (REQ)**

The peripheral devices assert REQ to request data transfers. See the "Requests" section for details.

(2) **Acknowledge (ACK)**

This line is used to implicitly address the device which is transferring the data (This device is not selected by address lines.) It is also asserted when the content of DAR is outputted during memory-to-memory transfer except for the auto-request mode at a limited rate or at the maximum rate.

(3) **Peripheral Control Line (PCL)**

The function of this line is quite flexible and is determined by the DCR (Device Control Register).

The DTYP bits of the DCR define what type of device is on the channel. If the DTYP bits are programmed to be a HMCS6800 device, the PCL definition is ignored and the PCL line is an Enable clock (E clock) input. If the DTYP bits are programmed to be a device with READY, the PCL definition is ignored and the PCL line is a ready input.

PCL As a Status Input

The PCL line may be programmed as a status input. The status level of this line can be determined by the PCS bit in the CSR, regardless of the PCL function determined by the DCR. If a negative transition occurs and remains stable for a minimum of two clocks, the PCT bit of the CSR is set. This PCT bit is cleared by resetting the DMAC or the writing "1" to the PCT bit.

PCL As an Interrupt

The PCL line may be programmed to generate an interrupt on a negative transition. This enables an interrupt which is requested if the PCT bit of the CSR is set. When using this function, it is necessary to reset the PCT bit in the CSR before the PCL bit in the DCR is set to interrupt, in order to avoid assertion of IRQ line at this time.

PCL As a Starting Pulse

The PCL line may be programmed to output a starting pulse. This active low starting pulse is outputted when a channel is activated, and is "Low" for a period of four clock cycles.

PCL As an Abort Input

The PCL line may be programmed to be a negative transition above input which terminates an operation by setting the external abort error in CER. It is necessary to reset the PCT bit in the CSR before activating the channel (Setting the ACT bit of CCR) so that the channel operation is not immediately aborted.

PCL As an Enable Clock (E Clock) Input

If the DTYP bits are programmed to be a HMCS6800 device, the PCL definition is ignored and the PCL line is an Enable Clock input. The Enable clock downtime must be as long as five clock cycles, and must be high for a minimum of three DMAC clock cycles, but need not be synchronous with the DMAC's clock.

PCL As a READY Input

If the DTYP bits are programmed to be a device with READY, the PCL definition is ignored and the PCL line is a READY input. The READY is an active low input.

(4) **DONE (DONE)**

This line is an active low Input/Output signal with an open drain. It is asserted when the memory transfer count is exhausted in a single block transfer. In the chaining operation, DONE is asserted only at the last transfer to the peripheral

device of the last data block. In the continue mode, DONE is asserted for each data block. It is asserted and negated in coincident with the ACK line for the last data transfer to the peripheral device. It is also outputted in coincident with the ACK line of the last bus cycle, in which the address is outputted from the DAR, in the memory-to-memory transfer (dual addressing mode) that uses the ACK line.

The DMAC also monitors the state of the DONE line during the DMA bus cycle. If the device asserts DONE during ACK active, the DMAC will terminate the operation after the transfer of the current operand. If DONE is asserted on the first byte of 2 byte operation or the first word of long word operation, the DMAC does not terminate the operation until the whole operand transfer is completed. If DONE is inserted, then the DMAC terminates the operation by clearing the ACT bit of the CSR, and setting the COC and NDT bits of the CSR. If both the DMAC and the device assert DONE, the device termination is not recognized, but the channel operation does terminate. DONE is outputted again for the retry exceptions bus cycles.

(5) **Data Transfer Complete (DTC)**

DTC is an active low signal which is asserted when the actual data transfer is accomplished. It is also asserted in the bus cycle when a chain information is read from memory in the Chaining mode. However, if exceptions are generated and the DMA bus cycle terminates, DTC is not asserted. DTC is asserted one half clock before LDS and UDS are negated, and negated one half clock after LDS and UDS are negated.

● **Requests**

Requests may be externally generated by circuitry in the peripheral device, or internally generated by the auto-request mechanism. The REQ bits of the OCR determine these modes. The DMAC also supports an operation in which the DMAC auto-requests the first transfer and then waits for the peripheral device to request the following transfers.

(1) **Auto-request Transfers**

The auto-request mechanism provides generation of requests within the DMAC. These requests can be generated at either of two rates: maximum-rate and limited-rate. In the former case, the channel always has a request pending.

The limited rate auto-request functions by monitoring the bus utilization.

Limited-rate Auto-request

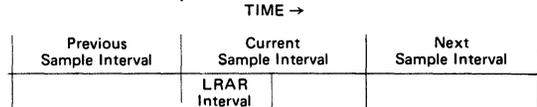


Figure 14 DMAC Sample Intervals

In the limited-rate auto-request the DMAC divides time into equal length sample intervals by counting clock cycles. The end of one sample interval makes the beginning of the next. During a sample interval, the DMAC monitors by means of BGACK pin the system bus activity of the DMAC and other bus master devices. At the end of the sample interval, decision is made whether or not to perform the channel's data transfer during the next sample interval. Namely, based on the activity of the DMAC or other bus master devices during the current sample interval, the DMAC allows limited-rate auto-requests for some initial portion of the next sample interval.

The length of the sample interval, and the portion of the sample interval during which limited-rate auto-requests can be

made (the limited-rate auto-request interval) are controlled by the BT and BR bits in the GCR. The length in clock cycles of the limited-rate auto-request interval is $2^{(BT+4)}$ (2 raised to the BT+4 power). For example, if BT equals 2 and the DMA utilization of the bus was low during the previous sample interval, then the DMAC generates the auto-request transfers during the first 64 clock cycles.

The ratio of the length of the sample interval to the length of the limited-rate auto-request interval is controlled by the BR bits. The ratio of the system bus utilization of the MPU to other bus master devices including the DMAC is $2^{(BR+1)}$ (2 raised to the BR+1 power). If the fraction of DMA clock cycles during the sample interval exceeds the programmed utilization level, the DMAC will not allow limited-rate auto-requests during the next sample interval.

For example, if BR equals 3, then at most one out of 16 clock cycles during a sample interval can be used by the DMAC and other bus master devices, and still the DMAC would allow limited rate auto-request during the next sample interval. Therefore, from the viewpoint of long period, the ratio of the system bus utilization of the MPU to I/O devices including the DMAC is about 16:1. The sample interval length is not a direct parameter, but it is equal to $2^{(BT+BR+5)}$ clock cycles. Thus, the sample interval can be programmed between 32 and 2048

clock cycles.

The DMAC uses the \overline{BGACK} to differentiate between the MPU bus cycle and DMAC or other bus master devices. If \overline{BGACK} is active, then the DMAC assumes that the bus is used by a DMAC or other bus master devices. If it is inactive, then the DMAC assumes that it is used by the MPU.

Maximum-rate Auto-request

If the REQ bits in the OCR indicate auto-request at the maximum rate, the DMAC acquires the bus after the start bit is set and keeps it until the data transfer is completed.

If a request is made by another channel of higher priority, the DMAC services that channel and then resumes the auto-request sequence. If two or more channels are set to equal priority level and maximum rate auto-request, then the channels will rotate in a "round robin" fashion.

If the HMCS68000 compatible device is connected to a channel, the ACK line is held inactive during an auto-request operation. Consequently, any channel may be used for the memory-to-memory transfer with the auto-request function in addition to the operation of data transfer between memory and peripheral device with using the \overline{REQ} pin. Refer to Figure 15 for the timing of the memory-to-memory transfer. In this mode, the ACK, HIBYTE and DONE outputs are always inactive.

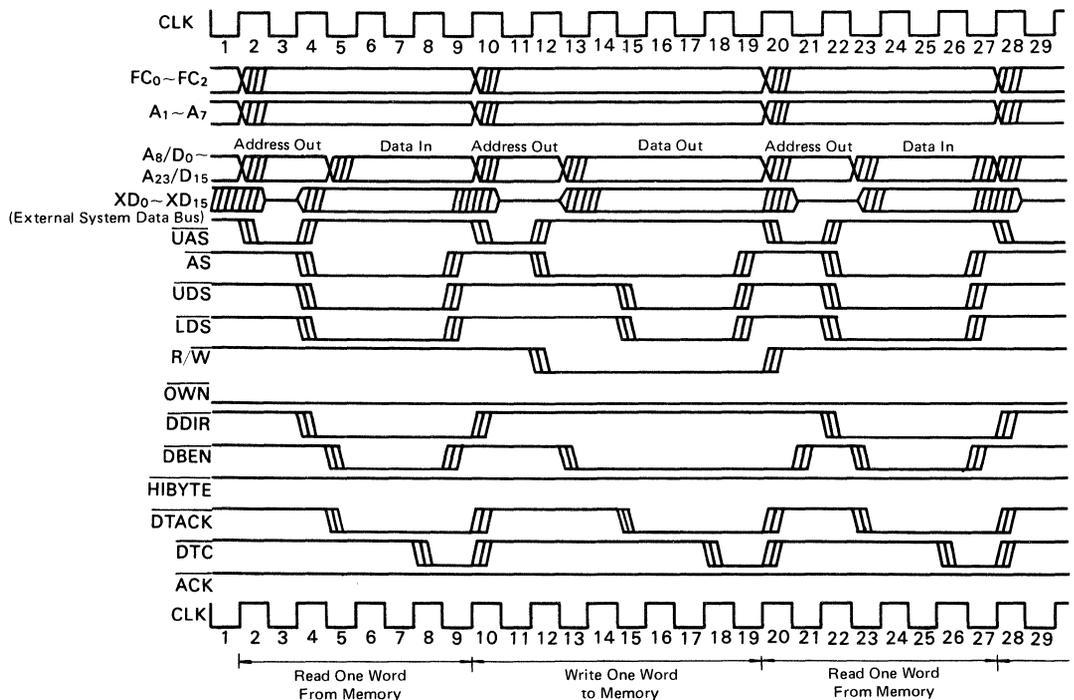


Figure 15 Memory-to-Memory Transfer
Read-Write-Read Cycles

(2) External Requests

If the REQ bits of the OCR indicate that the \overline{REQ} line generates requests, the transfer requests are generated externally. The request line associated with each channel allows the device to externally generate requests for DMA transfers. When the device wants an operand transferred, it makes a request by asserting the request line. The external request mode is determined by the XRM bits of the DCR, which allows both burst and cycle steal request modes. The burst request mode allows a channel to request the transfer of multiple operands using consecutive bus cycles. The cycle steal request mode allows a channel to request the transfer of a single operand. The

following is the description of the burst and the cycle steal modes.

Burst Request Recognition

In the burst request mode, the \overline{REQ} line is an active low input. The level sampled at the rising edge of the clock. Once the burst request is asserted, it needs to be held low until the first DMA bus cycle starts in order to insure at least one data transfer operation. In order to stop the burst mode transfer after the current bus cycle, the \overline{REQ} line has to be negated one clock before the \overline{DTC} output clock of this cycle. Refer to Figure 16 or the burst mode timing.

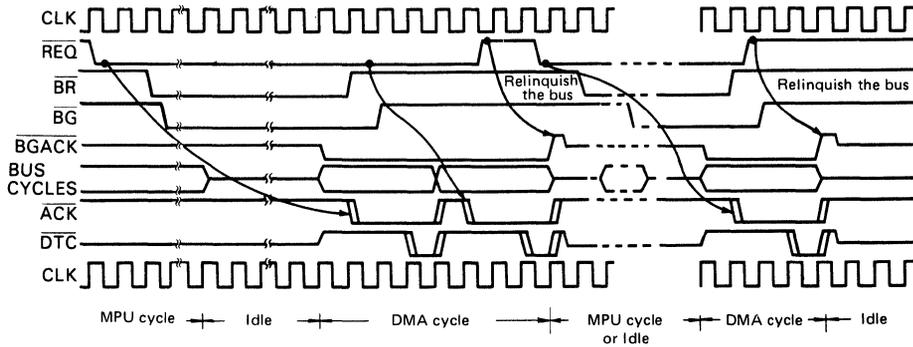


Figure 16 Burst Mode Request Timing
(Only one channel is active)

Cycle Steal Request Recognition

In the cycle steal request mode, the peripheral device requests the DMA transfer by generating an falling edge at the \overline{REQ} line. The \overline{REQ} line needs to be held "low" for at least 2 clock cycles. In the cycle steal mode, if the \overline{REQ} line changes from "High" to "Low" between \overline{ACK} output and one clock before the clock that outputs \overline{DTC} , then the next DMA transfer is performed without relinquishing the bus. If the bus is not relinquished, then maximum of 5 idle clocks is inserted between bus cycles. Refer to Figure 17 for the request timing of the cycle steal mode. If the XRM bits specify cycle steal without hold, the DMAC will relinquish the bus. If the XRM bits specify cycle steal with hold, the DMAC will retain ownership. The bus is not given up for arbitration until the channel opera-

tion terminates or until the device pauses. The device is determined to have paused if it does not make any requests during the next full sample interval. The sample interval counter is free running and is not reset or modified by this mode of operation. The sample interval counter is the same counter that is used for Limited Rate Auto Request and is programmed via the GCR. Figure 18 shows the request timing in the cycle steal bus hold. If the \overline{REQ} is inputted during the hold time, the \overline{ACK} is outputted after a maximum of 7.5 clock cycles from the picked-up clock. On the cycle steal with hold mode, the DMAC will hold the bus even when the transfer count is exhausted and the last data has been transferred. If DMA transfer is requested from other channels during this period, they are executed normally.

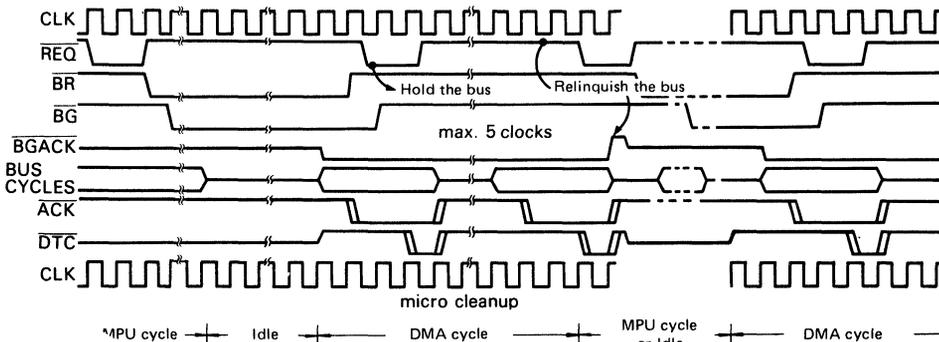


Figure 17 Cycle Steal Mode Request Timing

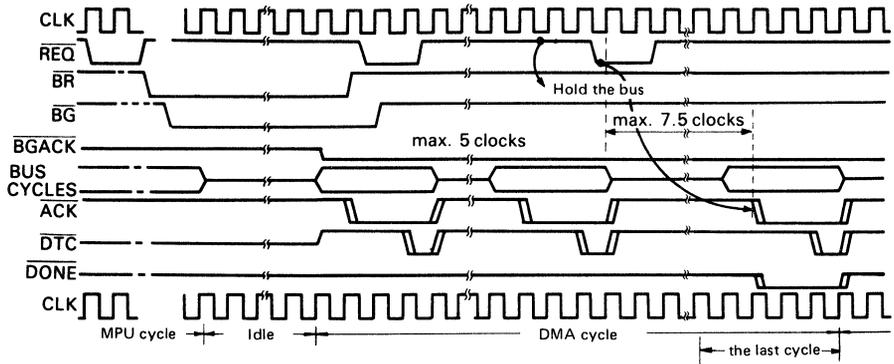


Figure 18 Cycle Steal Bus Hold Mode Request Timing

Request Recognition in Dual-address Transfers

In the following section dual-address transfers is defined. Dual address transfer is an exception to the request recognition rules in the previous paragraphs. In the cycle steal request mode, when there are two or more than transfers between the DMAC and the peripheral device during one operand transfer, the request is not recognized until the last transfer between the DMAC and the I/O device starts.

(3) Mixed Request Generation

A single channel can mix the two request generation methods. By programming the REQ bits of the OCR to "11", when the channel is started, the DMAC auto-requests the first transfer. Subsequent requests are then generated externally by the device. The ACK and PCL lines perform their normal functions in this operation.

• **Data Transfers**

All DMAC data transfers are assumed to be between memory and the peripheral device. The word "memory" means a 16-bit HMCS68000 bus compatible device. By programming the DCR, the characteristics of the peripheral device may be assigned. Each channel can communicate using any of the following protocols.

D ^{TYP}	Device Type	
00	HMCS68000 compatible device	} Dual Addressing
01	HMCS6800 compatible device	
10	Device with \overline{ACK}	} Single Addressing
11	Device with \overline{ACK} and \overline{READY}	

(1) Dual Addressing

HMCS68000 and HMCS6800 compatible devices may be explicitly addressed. This means that before the peripheral transfers data, a data register within the device must be explicitly addressed. Because the address bus is used to address the peripheral, the data cannot be directly transferred to/from the memory because the memory also requires addressing. Instead, the data is transferred from the source to the DMAC and held in an internal DMAC holding register. A second bus transfer between the DMAC and the destination is then required to complete the operation. Because both the source and destination of the transfer are explicitly addressed, this protocol is called dual-addressed.

HMCS68000 Compatible Device Transfers

In this operation, when a request is received, the bus is obtained and the transfer is completed using the protocol as shown in Figures 19 and 20. Figures 21 through 24 show the transfer timings. Figure 21 and 24 show the operation when the memory is the source and the peripheral device is the destination. Figures 22 and 23 show the transfer in the opposite direction. The peripheral device is a 16-bit device in Figures 21 and 22, and a 8-bit device in Figures 23 and 24.

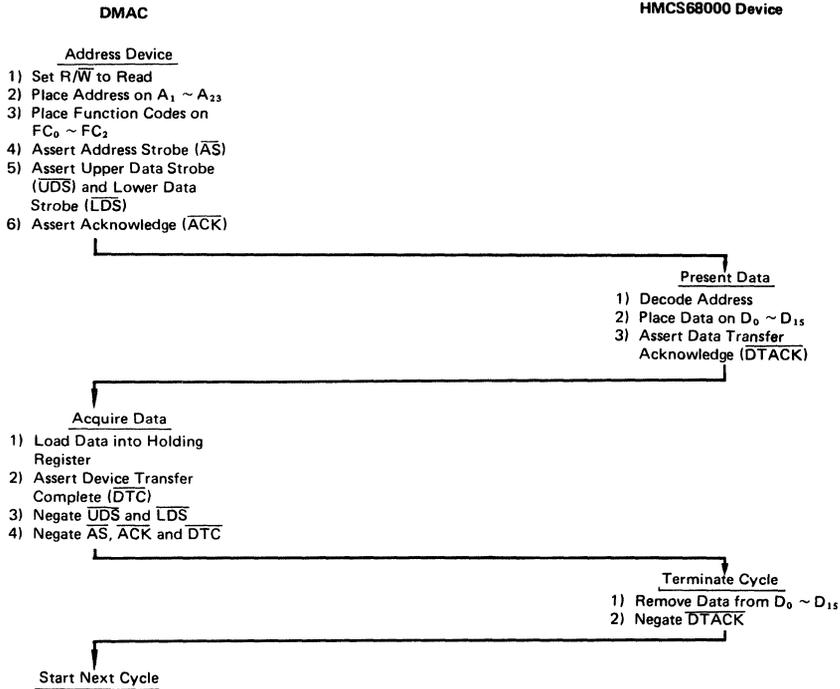


Figure 19 Word Read Cycle Flowchart HMCS68000 Type Device

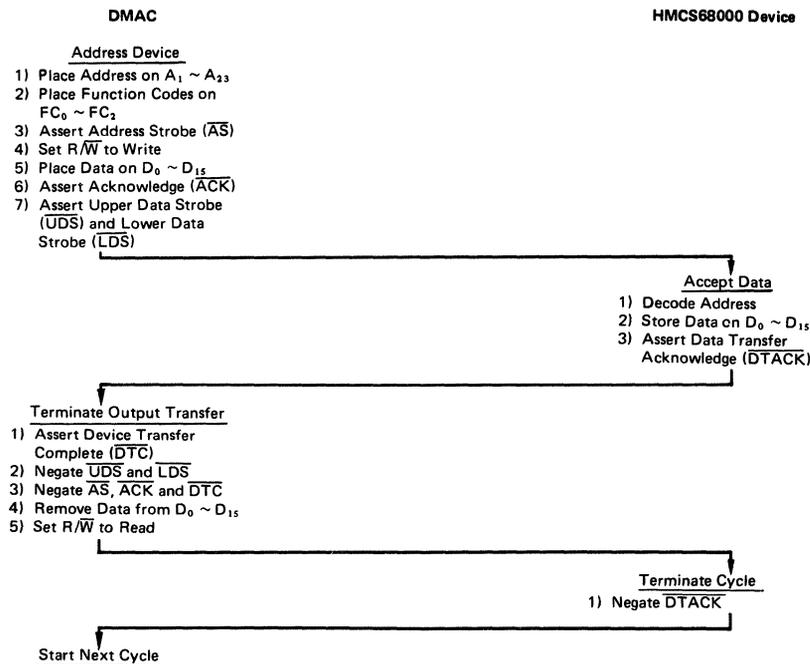


Figure 20 Word Write Cycle Flowchart HMCS68000 Type Device

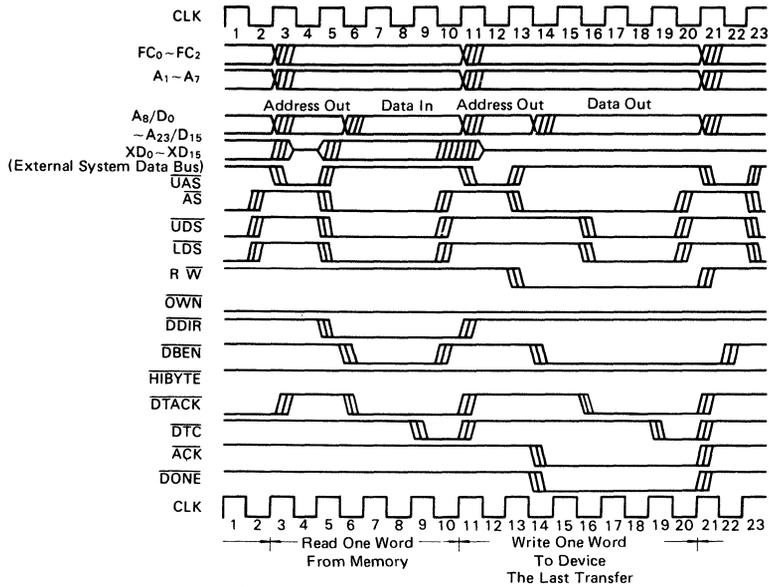


Figure 21 Dual Addressing Mode, Read/Write Cycle, Destination = 16-bit Device, Word Operand

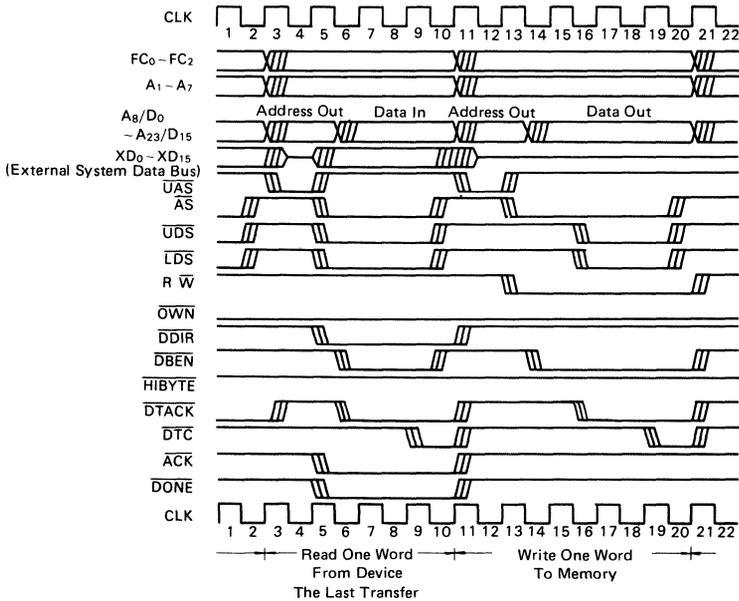


Figure 22 Dual Addressing Mode, Read/Write Cycle, Source = 16-bit Device, Word Operand

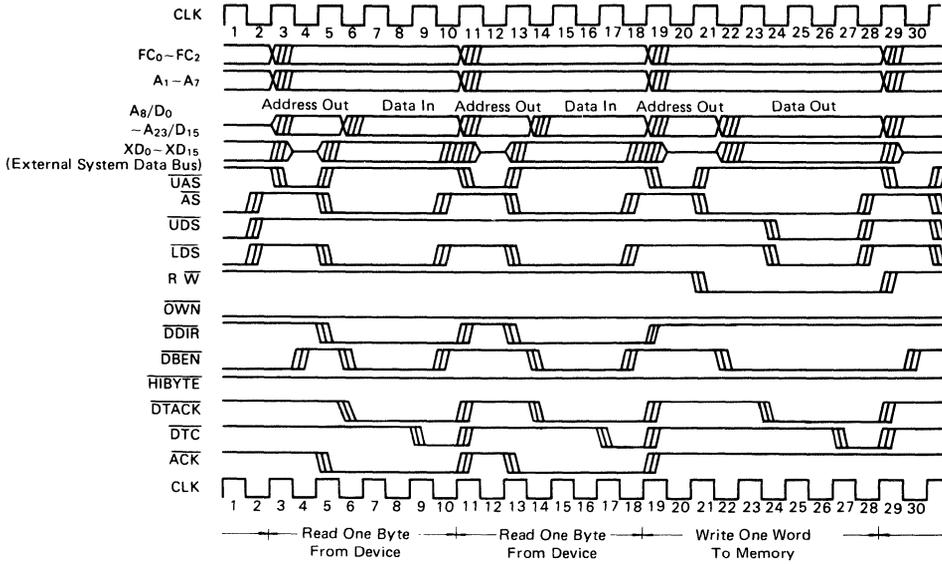


Figure 23 Dual Addressing Mode, Read/Write Cycle
Source = 8-bit Device, Word Operand

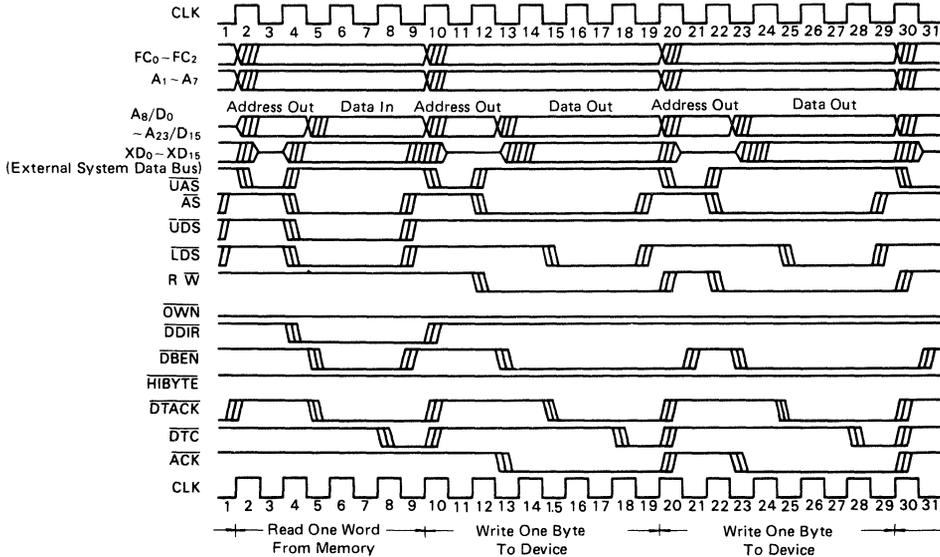


Figure 24 Dual Addressing Mode, Read/Write Cycle,
Destination = 8-bit Device, Word Operand

HMCS6800 Compatible Device Transfers

When a channel is programmed to perform HMCS6800 compatible transfers, the \overline{PCL} line for that channel is defined as an Enable clock input. The DMAC performs data transfers between itself and the peripheral device using the HMCS6800 bus protocol, with the \overline{ACK} output providing the \overline{VMA} (valid memory

address) signal. Figure 25 illustrates this protocol. Refer to Figure 26 for the read cycle timing and Figure 27 for the write cycle timing. In Figure 26, the DMAC latches the data at the falling edge of clock 19, so a latch to hold the data is necessary as shown in Figure 47.

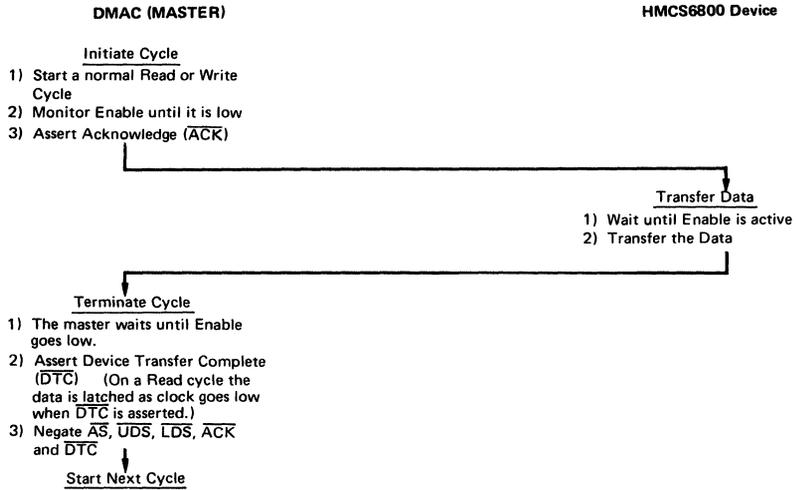


Figure 25 HMCS6800 Cycle Flowchart

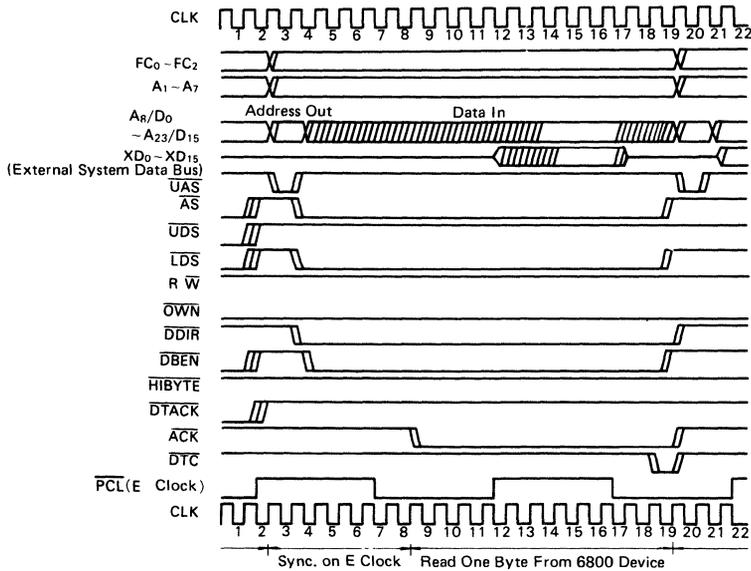


Figure 26 Dual Addressing Mode, HMCS6800 Compatible Device, Read Cycle

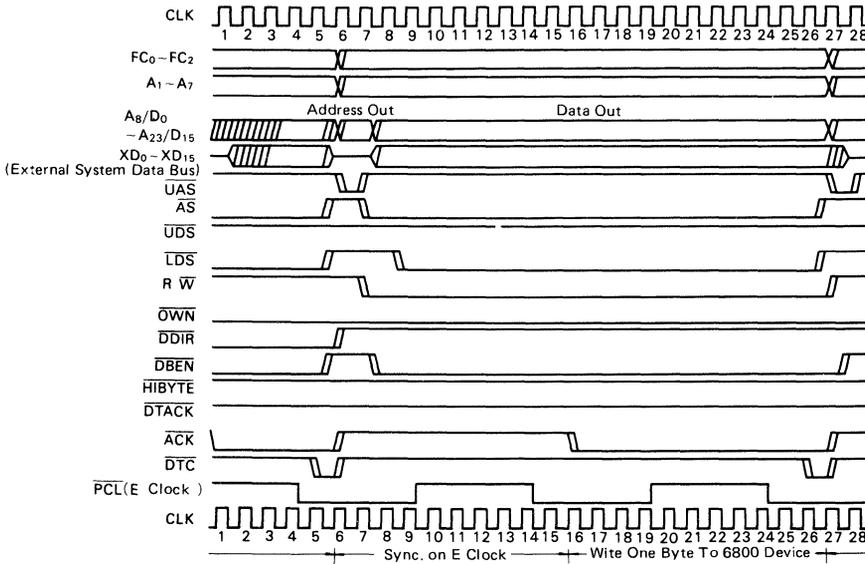


Figure 27 Dual Addressing Mode, HMCS6800 Compatible Device, Write Cycle

(2) Single Addressing Mode

Implicitly addressed devices are peripheral devices selected not by address but by \overline{ACK} . They do not require addressing of data register during data transfer. Transfers between memory and these devices are controlled by the request/acknowledge protocol. Such peripherals require only one bus cycle to transfer data, and the DMAC internal holding register is not used. Because only the memory is addressed during a data transfer and a transfer done in only on bus cycle, this protocol is called single-address.

Device with \overline{ACK} Transfers

Under this protocol, the communication between peripheral device and the DMAC is performed with a two signal $\overline{REQ}/\overline{ACK}$ handshake. When a request is generated using the request method programmed in the DMAC's internal control registers, the DMAC obtains the bus and responds with \overline{ACK} . The DMAC asserts all the bus control signals required for the memory access. Refer to Figure 28 for the flowchart of the data transfer from memory to the device with \overline{ACK} . Figure 29 shows the flowchart of the data transfer from the device with \overline{ACK} to memory. When a request is generated using the request method programmed in the control registers, the DMAC obtains the bus and responds with acknowledge. The DMAC asserts all HMCS68000 bus control signals needed for the transfer. When the DMAC accepts \overline{DTACK} from memory, it asserts \overline{DTC} and informs the

peripheral device of the transfer termination. Figure 30 and 31 show the transfer timings of the device with \overline{ACK} : the port size for the former figure is 8-bit and the latter is 16-bit respectively.

When the transfer is from memory to a device, data is valid when \overline{DTACK} is asserted and remains valid until the data strobes are negated. The assertion of \overline{DTC} from the DMAC may be used to latch the data.

When the transfer is from device to memory, data must be valid on the HMCS68000 bus before the DMAC asserts the data strobes. The data strobes are asserted one clock period after \overline{ACK} is asserted. When the DMAC obtains the bus and starts a DMA cycle, the tri-state of the \overline{OWN} line is cancelled a half clock earlier than other control lines. If the DMA Cycle terminates and the DMAC relinquishes the bus, all the control signals get tri-stated a half clock before \overline{OWN} . The \overline{DDIR} and \overline{DBEN} lines are not asserted in the single addressing mode. Four clocks cycle is the smallest bus cycle for the transfer from memory to device. Five clocks cycle is the smallest bus cycle for the transfer from device to memory. If the device port size is 8-bit, either \overline{LDS} or \overline{UDS} is asserted. In the single addressing mode, A_8-A_{23} are outputted for only one and a half clock from the beginning of the DMA bus cycle. Therefore, A_8 through A_{23} needs to be latched externally just like in the dual addressing mode.

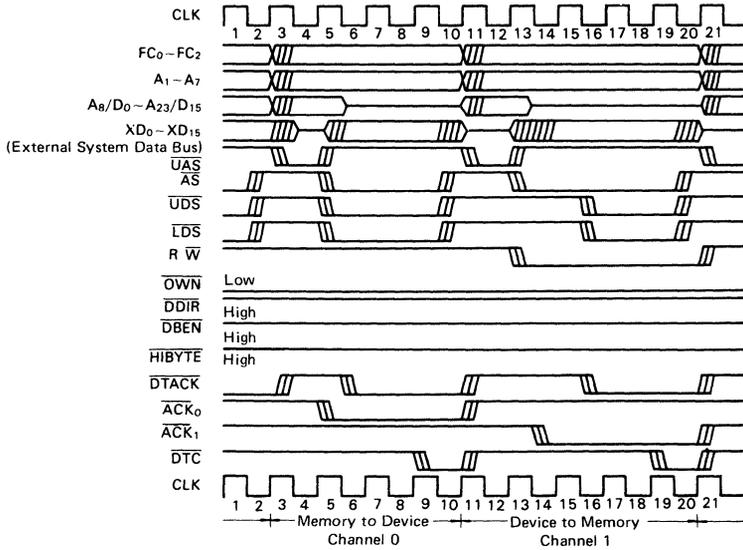


Figure 30 Single Addressing Mode with 16-Bit Devices as Source and Destination (Read-Write Cycles)

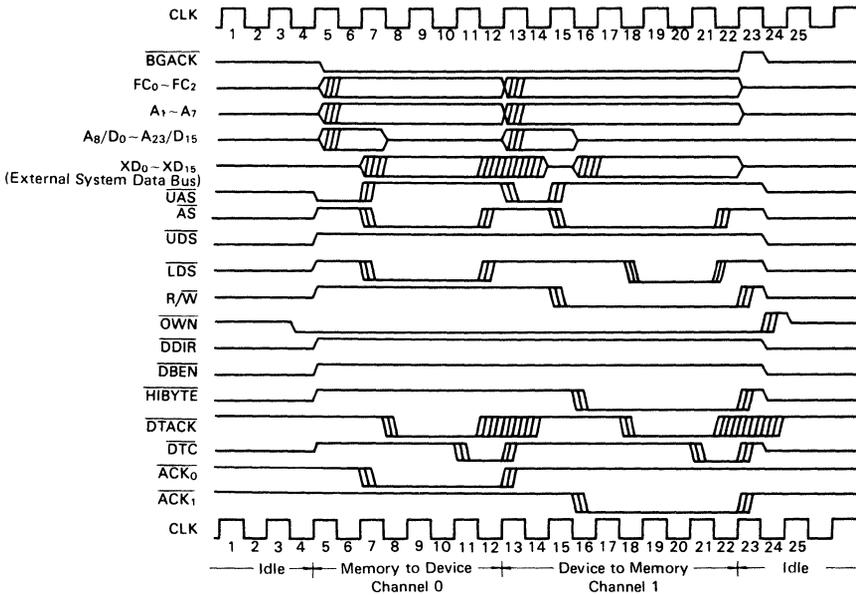


Figure 31 Single Addressing Mode with 8-Bit Device as Source and Destination (Read-Write Cycles)

Device with $\overline{\text{ACK}}$ and $\overline{\text{READY}}$ Transfers

Under this protocol, the communication between peripheral device and the DMAC is performed using a three signal $\overline{\text{REQ}}/\overline{\text{ACK}}/\overline{\text{READY}}$ handshake. The $\overline{\text{READY}}$ input to the DMAC is provided by the PCL line. The $\overline{\text{READY}}$ line is active low. When a request is generated using the request method programmed in the control registers, the DMAC obtains the bus and asserts $\overline{\text{ACK}}$ to notify the device that the transfer is to take place. The DMAC waits for $\overline{\text{READY}}$ ($\overline{\text{PCL}}$ input), which is a response from the device, in addition to $\overline{\text{DTACK}}$ which is a response from memory.

When the DMAC accepts both signals, it terminates the transfer. Refer to Figures 33 and 34 for the flowcharts of the data transfer between memory and the device with $\overline{\text{ACK}}$ and $\overline{\text{READY}}$. Refer to Figure 35 for the transfer timing of the 8-bit device. When the data transfer is from memory to a device, data is valid from the assertion of $\overline{\text{DTACK}}$ to the negation of $\overline{\text{LDS}}$ and $\overline{\text{UDS}}$. $\overline{\text{DTC}}$ is asserted a half clock before $\overline{\text{LDS}}$ and $\overline{\text{UDS}}$ are negated, so this line may be used for latching the data by the peripheral device. In this case, $\overline{\text{READY}}$ ($\overline{\text{PCL}}$ input) indicates that the device has received the data. Both $\overline{\text{DTACK}}$ and $\overline{\text{READY}}$ ($\overline{\text{PCL}}$ input) signals are needed for terminating the DMA cycle.

When the data transfer is from the device to memory, data must be valid on the bus before the DMAC asserts $\overline{\text{LDS}}$ and $\overline{\text{UDS}}$. Therefore, $\overline{\text{READY}}$ ($\overline{\text{PCL}}$ input) is used as the signal to indicate that the peripheral device has outputted the data on the bus. When the DMAC detects $\overline{\text{PCL}}$ ($\overline{\text{READY}}$ input), then it

asserts $\overline{\text{LDS}}$ and $\overline{\text{UDS}}$. After asserting $\overline{\text{LDS}}$ and $\overline{\text{UDS}}$, the DMAC terminates the cycle when $\overline{\text{DTACK}}$ signal from the memory is detected.

When Array Chain or Link Array Chain is set in Device with $\overline{\text{ACK}}$ and $\overline{\text{READY}}$ Transfer mode, $\overline{\text{READY}}$ input is also necessary during DMA bus cycles for reading the chain information from memory. The circuit as shown in Figure 32 may be used in order to generate $\overline{\text{READY}}$ input when reading the chain information from memory.

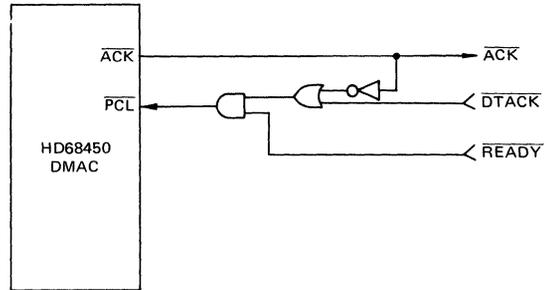


Figure 32 $\overline{\text{READY}}$ Circuit When Array or Link Array Chain is set for Device with $\overline{\text{ACK}}$ and $\overline{\text{READY}}$

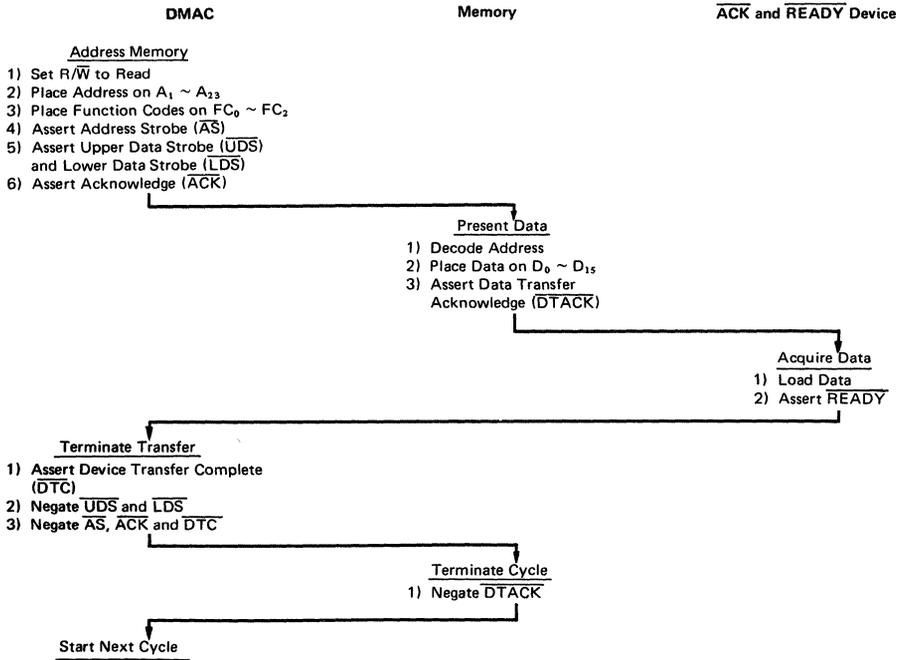


Figure 33 Word from Memory to Device with $\overline{\text{ACK}}$ and $\overline{\text{READY}}$

Operands and Addressing

Three factors enter into how the actual data is handled: port size, operand size and address sequencing.

Port Size

The DCR is used to program the device port size.

DPS Device Port Size

- 0 8 bit port
- 1 16 bit port

The port size is the number of bits of data which the device can transfer in a single bus cycle. During a DMAC bus cycle, a 16-bit port transfers 16 bits of data on D₀ ~ D₁₅, while an 8-bit port transfers 8 bits of data, either on D₀ ~ D₇ or on D₈ ~ D₁₅. The memory is always assumed to have a port size of 16.

Operand Size

OCR is used to program the operand size.

SIZE Operand Size

- 00 Byte
- 01 Word
- 10 Long word
- 11 (undefined, reserved)

The operand size is the number of bits of data to be transferred to honor a single request. Multiple bus cycles may be required to transfer the operand through the device port. A byte operand consists of 8 bits of data, a word operand consists of 16 bits of data, a long word operand consists of 32 bits of data. The transfer counter counts the number of operands transferred.

Table 2 indicates the combinations supported by the DMAC about the peripheral devices with different port size and operand sizes in the single and dual addressing mode. In the single addressing mode, port size and operand size must be the same. In the dual addressing mode, byte operand cannot be used when the port size is sixteen and the REQG bit is 10 or 11.

Table 2 Operation Combinations

Addressing	Device Type	Port	Operand			REQG bits of OCR
			Byte	Word	Long Word	
Dual	68000, 6800	8	○	○	○	00, 01, 10, 11
Dual	68000, 6800	16	○	○	○	00, 01
Dual	68000, 6800	16	X	○	○	10, 11
Single	with $\overline{\text{ACK}}$ or $\overline{\text{ACK}} \& \overline{\text{READY}}$	8	○	X	X	00, 01, 10, 11
		16	X	○	X	00, 01, 10, 11

○ ; enable X ; disable

(3) Address Sequencing

The sequence of addresses generated depends upon the port size, operand size, whether the addresses are to count up, down or not change and whether the transfer is executed in the single addressing mode or the dual addressing mode. The memory address count method and the peripheral device address count method is programmed using the Memory address count (MAC) bit and the Device address count (DAC) bit in the Sequence Control Register (SCR).

(i) Single addressing mode

In the single addressing mode, memory address sequenc-

ing is shown in Table 3. If the operand size is byte, the memory address increment is one (1). If the operand size is word, the memory address increment is two (2). If the memory address register does not count, the memory address is unchanged after the transfer.

If the memory address counts up, the increment is added to the memory address; if the memory address counts down, the increment is subtracted from the memory address. The memory address is changed after the operand is transferred.

Table 3 Single Address Sequencing

Port Size	Operand Size	Memory Address Increment		
		+ (increment)	= (unchanged)	- (decrement)
8	Byte	+1	0	-1
16	Word	+2	0	-2

(ii) Dual addressing mode

In the dual addressing mode, the operand size need not match the port size. Thus the transfer of an operand may require several DMA bus cycles. Each DMA bus cycle, between memory and DMAC and between DMAC and the device, is called the operand part and transfers a portion or all of the operand. The addresses of the operand parts are in a linear increasing sequence. The step between the addresses of the operand is two. The size of the operand parts is the minimum of the port size and the operand size. The number of the operand part is the operand size divided by the port size. In the dual addressing mode, memory is regarded as a device whose port size is 16-bits.

If the port size is 16 bits, the operand size is byte, and the

request generation method is auto request or auto request at a limited rate, the DMAC packs consecutive transfers. This means that word transfers are made from the associated address with an address increment of two (2). If the initial source address location contains a single byte, the first transfer is a byte transfer to the internal DMAC holding register, and subsequent transfers from the source are word transfers. If the initial destination location contains a single byte, the first transfer is a byte transfer from the internal DMAC holding register, and any remaining byte remains in the holding register. Likewise, if either the final source or destination location contains a single byte, only a byte transfer is done. Packing is not performed if the address does not count; each byte is transferred by a separate access to the same location. The dual address sequencing is shown in Table 4.

Table 4 Dual Address Sequencing

Port Size	Operand Size	Part Size	Operand Part Address	Address Increment		
				+	=	-
8	Byte	Byte	A	+2	0	-2
8	Word	Byte	A, A+2	+4	0	-4
8	Long	Byte	A, A+2, A+4, A+6	+8	0	-8
16	Byte	Pack	A	+P	0	-P
16	Word	Word	A	+2	0	-2
16	Long	Word	A, A+2	+4	0	-4

P = 1 if packing is not done
= 2 if packing is done

Pack = byte if packing is not done
= word if packing is done

An Example of a Dual Address Transfer

This section contains an example of a dual address transfer using Table 4 of Dual-Address Sequencing. The table is reproduced here as Table 5. The transfer mode of this example is the following:

1. Device Port size = 8 bits
2. Operand size = Long Word (32 bits)
3. Memory to Device Transfer
4. Source (Memory) Counts up, Destination (Device) Counts Down
5. Memory Transfer Counter = 2

In this mode, a data transfer from the source (memory) is done according to the 6th row of Table 5, since the port size of the memory is always 16 bits. A data transfer to the destination (device) is done according to the 3rd row of Table 5. Table 6 shows the data transfer sequence.

The memory map of this example is shown in Table 7. The operand consists of BYTE A through BYTE D in memory of Table 7. Prior to the transfer, MAR and DAR are set to 00000012 and 00000108 respectively. The operand is transferred to the 8 bit port device according to the order of transfer number in Table 6.

Table 5 Dual-Address Sequencing (Table 4)

Row No.	Port Size	Operand Size	Operand Part Size	Operand Part Addresses	Address Increment		
					+	=	-
1	8	BYTE	BYTE	A	+2	0	-2
2	8	WORD	BYTE	A, A+2	+4	0	-4
③	8	LONG	BYTE *4	A, A+2, A+4, A+6 *3 *5 *7 *8	+8	0	-8 *10
4	16	BYTE	PACK (BYTE or WORD)**	A	+P	0	-P
5	16	WORD	WORD	A	+2	0	-2
⑥	16	LONG	WORD *2	A, A+2 *1 *6	+4 *9	0	-4

* Numbers in Table 5 correspond to ones in Table 6 and 7.

** Refer to Address Sequencing on Operand Part Size and PACK.

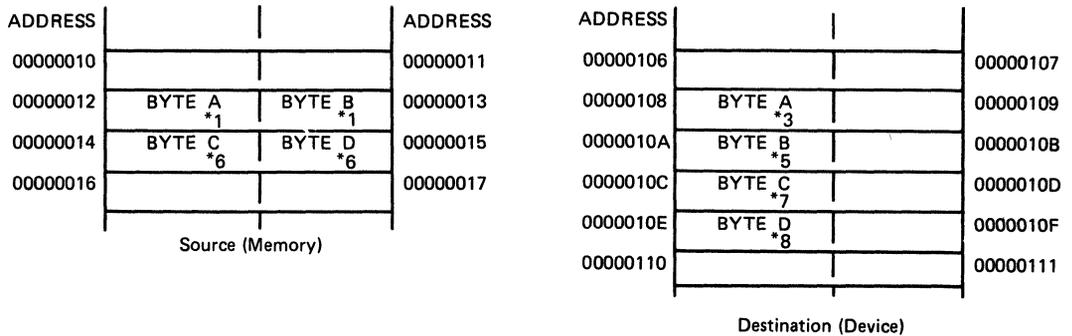
Table 6 An Example of a Data Transfer for One Operand

SRC: Source (Memory), DST Destination (Device), HR: Holding Register (DMAC Internal Reg.)

Transfer No.	Data Transfer	Address Output	Data Size on Bus	DMAC Registers after Transfer		Comment
				MAR	DAR	
0	—	—	—	00000012	00000108	Initial Register Setting
1	SRC → HR	00000012 ^{*1}	WORD ^{*2}	00000014	00000108	Higher order 16 bits of operand is fetched.
2	HR → DST	00000108 ^{*3}	BYTE ^{*4}	00000014	0000010A	Higher order 16 bits of operand is transferred.
3	HR → DST	0000010A ^{*5}	BYTE ^{*4}	00000014	0000010C ^{*10}	
4	SRC → HR	00000014 ^{*6}	WORD ^{*2}	00000016 ^{*9}	0000010C	Lower order 16 bits of operand is fetched
5	HR → DST	0000010C ^{*7}	BYTE ^{*4}	00000016	0000010E	Lower order 16 bits of operand is transferred.
6	HR → DST	0000010E ^{*8}	BYTE ^{*4}	00000016	00000110 ^{*10}	
6'	—	—	—	00000016	00000110'	MAR, DAR are pointing the next operand addresses when the transfer is complete.

Mode: Port size = 8, Operand size = Long Word, Memory to Device, Source (Memory) Counts Up, Destination (Device) Counts Down

Table 7 Memory Map for the Example of the Data Transfer



● Initiation and Control of Channel Operation

(1) Operation Initiation

To initiate the operation of a channel the STR bit of the CCR is set to start the operation. Setting the STR bit causes the immediate activation of the channel, the channel will be ready to accept requests immediately. The channel initiates the operation by resetting the STR bit and setting the channel active bit in the CSR. Any pending requests are cleared, and the channel is then ready to receive requests for the new operation. If the channel is configured for an illegal operation, the configuration error is signaled, and no channel operation is run. The illegal operations include the selection of any of the options marked "(undefined, reserved)". If the MTC is set to zero in any operation or BTC is set to zero in the array chaining mode, then the count error is signaled and the channel is not activated. The channel cannot be started if any of the ACT, COC, BTC, NDT or ERR bits is set in the CSR. In this case, the channel signals the operation timing error.

(2) Operation Continuation (Continue Mode)

The continue bit (CNT) allows multiple blocks to be transferred in unchained operations. The CNT bit is set in order to continue the current channel operation. If an attempt is made to continue a chained operation, a configuration error is signaled. The base address register and base transfer counter should have been previously initialized.

The continue bit may be set as the channel is started or while the channel is still active. The operation timing error bit is signaled if a continuation is otherwise attempted.

When the memory transfer counter is exhausted and the continue bit of the CCR is set, the DMAC performs a continuation of the channel operation. The base address, base function code, and base transfer count registers are copied into the memory address, memory function code, and memory transfer count registers. The block transfer complete (BTC) bit of the CSR is set, the continue bit is reset, and the channel begins a new block transfer. If the memory transfer counter is loaded with a terminal count, the count error is signaled.

(3) Operation Halting (Halt)

The CCR has a halt bit which allows suspension of the operation of the channel. If this bit is set, a request may still be generated and recognized, but the DMAC does not attempt to acquire the bus or to make transfers for the halted channel. When this bit is reset, the channel resumes operation and services any request that may have been received while the channel was halted. However, in the burst request mode, the transfer request should be kept asserted until the initiation of the first transfer after clearing the halt bit.

(4) Operation Abort by Software (Software Abort)

Setting the software abort bit (SAB) in the CCR allows the current operation of the channel to be aborted. In this case, the ERR bit and the COC bit in the CSR are set and the ACT bit is reset. The error code for the software abort is set in the CER. The SAB bit is designed to be reset if the ERR bit is reset. When the CCR is read, the SAB always reads as zero(0).

(5) Interrupt Enable

The CCR has an interrupt enable bit (INT) which allows the channel to request interrupts. If INT is set, the channel can request interrupts. If it is clear, the channel will not request interrupts.

● Channel Operation Termination

As part of the transfer of an operand, the DMAC decrements the memory transfer counter (MTC). If the chaining mode is not used and the CNT bit is not set or the last block is transferred in the chaining mode, the operation of the channel is complete when the last operand transfer is completed and the MTC is zero. The DMAC notifies the peripheral device of the channel completion via the $\overline{\text{DONE}}$ output.

However, in the continue mode, $\overline{\text{DONE}}$ is outputted at the termination of every data block transfer. When the channel operation has been completed, the ACT bit of the CSR is cleared, and the COC bit of the CSR is set.

The occurrence of errors, such as the bus error, during the DMA bus cycle also terminates the channel operation. In this case, the ACT bit in the CSR is cleared, the ERR and the COC bits are set, and at the same time the code corresponding to the error that occurred is set in the CER.

(1) Channel Status Register (CSR)

The channel status register contains the status of the channel. The register, except for ACT and PCS bits, is cleared by writing a one (1) into each bit of the register to be cleared. Those bit positions which contain a zero (0) in the write data remain unaffected. ACT and PCS bits are unaffected by the write operation.

COC

The channel operation complete (COC) bit is set if the channel operation has completed. The COC bit must be cleared in order to start another channel operation. The COC bit is cleared only by writing a one to this bit or resetting the DMAC.

PCS

The peripheral status (PCS) bit reflects the level of the $\overline{\text{PCL}}$ line regardless of its programmed function. If $\overline{\text{PCL}}$ is at "High" level, the PCS bit reads as one. If $\overline{\text{PCL}}$ is at "Low" level, the PCS bit reads as zero. The PCS bit is unaffected by writing to the CSR.

PCT

The peripheral control transition (PCT) bit is set, if a falling edge transition has occurred on the $\overline{\text{PCL}}$ line. (The $\overline{\text{PCL}}$ line must remain at "low" level for at least two clock cycles.) The PCT bit is cleared by writing a one to this bit or resetting the DMAC.

BTC

Block transfer complete (BTC) bit is set when the continue (CNT) bit of CCR is set and the memory transfer counter (MTC) is exhausted. The BTC bit must be cleared before the another continuation is attempted (namely, setting the CNT bit again), otherwise an operation timing error occurs. The BTC bit is cleared by writing a one to this bit or resetting the DMAC.

NDT

Normal device termination (NDT) bit is set when the peripheral device terminates the channel operation by asserting the $\overline{\text{DONE}}$ line while the peripheral device was being acknowledged. The NDT bit is cleared by writing a one to this bit or resetting the DMAC.

ERR

Error (ERR) bit is set if any errors have been signaled. When the ERR bit is set, the code corresponding to the kind of the error that occurred is set in the CER. The ERR bit is cleared by writing a one to this bit or resetting the DMAC.

ACT

The active (ACT) bit is asserted after the STR bit has been set and the channel operation has started. This bit remains set until the channel operation is terminated. The ACT bit is unaffected by write operations. This bit is cleared by the termination of the channel or resetting the DMAC.

(2) Interrupts

The DMAC can signal the termination of the channel operation by generating an interrupt request. The INT bit of the CCR determines if an interrupt can be generated. The interrupt request is generated by the following condition.

$$\text{(1) INT} = 1$$

and

$$\text{(2) COC} = 1 \text{ or } \text{BTC} = 1 \text{ or } \text{ERR} = 1 \text{ or } \text{NDT} = 1 \text{ or } \text{PCT} = 1$$

(the $\overline{\text{PCL}}$ line is an interrupt input)

This may be represented as

$$\overline{\text{IRQ}} = \overline{\text{INT}} \cdot (\text{COC} + \text{BTC} + \text{ERR} + \text{NDT} + \text{PCT}^*)$$

(* $\overline{\text{PCL}}$ line is programmed as an interrupt input.)

When the $\overline{\text{IRQ}}$ line is asserted, changing the INT bit from one to zero to one will cause the $\overline{\text{IRQ}}$ output to change from "low" to "high" to "low" again. The $\overline{\text{IRQ}}$ should be negated by clearing the COC, the BTC, the ERR, the NDT and the PCT bits.

If the DMAC receives $\overline{\text{TACK}}$ from the MPU during asserting the $\overline{\text{IRQ}}$, the DMAC provides an interrupt vector. If multiple channels have interrupt requests, the determination of which channel presents its interrupt vector is made using the same priority scheme defined for the channel operations.

The bus cycle in which the DMAC provides the interrupt vector when receiving an $\overline{\text{TACK}}$ from the MPU is called the interrupt acknowledge cycle. The interrupt vector returned to the MPU comes from either the normal or the error interrupt register. The normal interrupt register is used unless the ERR bit of CSR is set, in which case the error interrupt vector register is used. The content of the interrupt vector register is placed on $\text{D}_0 \sim \text{D}_7$, and $\overline{\text{DTACK}}$ is asserted to indicate that the vector is on the data bus. If a reset occurs, all interrupt vector registers are set to \$0F (binary 00001111), the value of the uninitialized interrupt vector. The timing of the interrupt acknowledge cycle is shown in Figure 36. The HD68000 MPU outputs the interrupt level into $\text{A}_1 \sim \text{A}_3$ and $\text{A}_4 \sim \text{A}_7$ is held "high" during the interrupt acknowledge cycle, but the HD68450 DMAC ignores these signals.

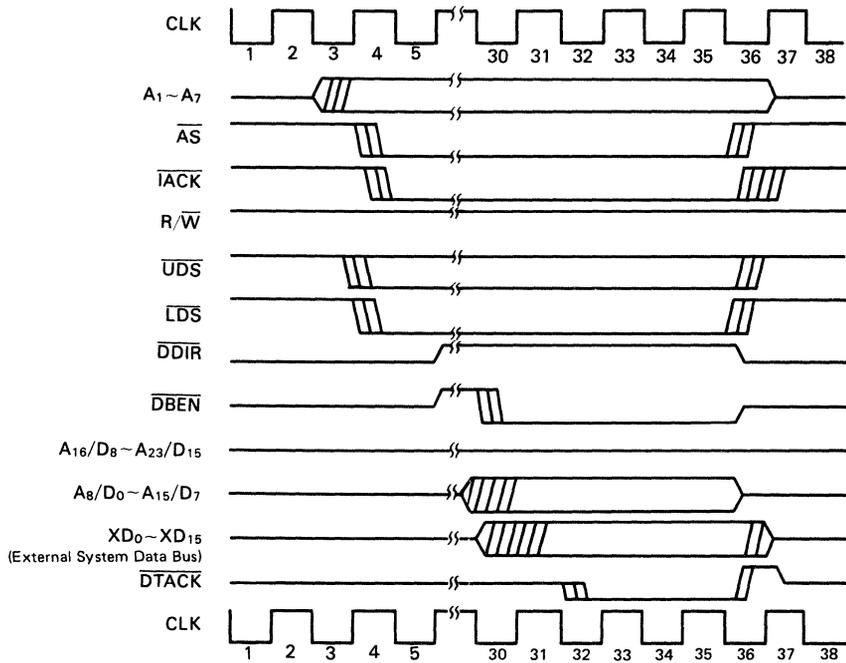


Figure 36 MPU $\overline{\text{IACK}}$ Cycle to DMAC

(3) Multiple Data Block Transfer Operation

When the memory transfer counter (MTC) is exhausted, the channel operation still continues if the channel is set to the array chaining mode or the linked array chaining mode and the chain is not exhausted. The channel operation also continues if the continue bit (CNT) of the CCR is set. The DMAC provides the initialization of the memory address register and the memory transfer counter in these cases so that the DMAC can transfer the multiple blocks.

Continued Operation

The continued operation is described in the Initiation and the Control of the Channel Operation section.

Array Chaining

This type of chaining uses an array in memory consisting of memory addresses and transfer counts. Each entry in the array is six bytes long and, consists of four bytes of address followed by two bytes of transfer count. The beginning address of this array is in the base address register, and the number of entries in the array is in the base transfer counter. Before starting any block transfers, the DMAC fetches the entry currently pointed

to by the base address register. The address information is placed in the memory address register, and the count information is placed in the memory transfer counter. As each chaining entry is fetched, the base transfer counter is decremented by one. After the chaining entry is fetched, the base address register is incremented to point the next entry. When the base transfer counter reaches a terminal count of zero, the chain is exhausted, and the entry just fetched determines the last block of the channel operation.

An example of the array chaining mode operation and the memory format for supporting for array chaining is shown in Figure 37. The array must start at an even address, or the entry fetch results is an address error. If a terminal count is loaded into the memory transfer counter or the base transfer counter, the count error is signaled. Since the base registers may be read by the MPU, appropriate error recovery information is available should the DMAC encounter an error anywhere in the chain. Contents of the BFC is outputted as the function code when the DMAC is accessing the memory using the base address register. The value of the function code registers are unchanged in the array chaining operation.

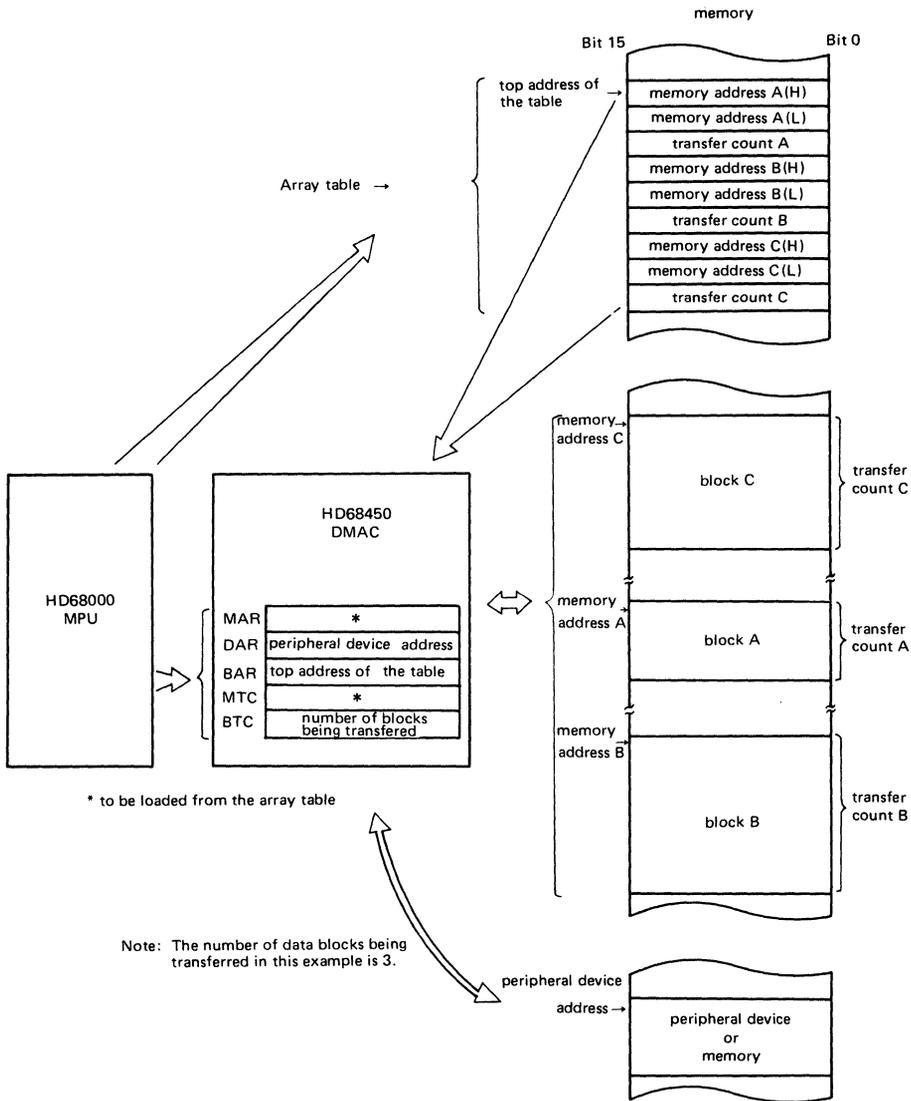


Figure 37 Transfer Example of the Array Chaining Mode

Linked Array Chaining

This type of chaining uses a list in memory consisting of memory address, transfer counts, and link addresses. Each entry in the chain list is ten bytes long, and consists of four bytes of memory address, two bytes of transfer count and four bytes of link address. The address of the first entry in the list is in the base address register, and the base transfer counter is unused. Before starting any block transfers, the DMAC fetches the entry currently pointed to by the base address register. The address information is placed in the memory address register, the count information is placed in the memory transfer counter,

and the link address replaces the current contents of the base address register. The channel then begins a new block transfer. As each chaining entry is fetched, the update base address register is examined for the terminal link which has all 32 bits equal to zero. When the new base address is the terminal address, the chain is exhausted, and the entry just fetched determines the last block of the channel operation.

An example of the linked array chaining mode operation and the memory format for supporting it is shown in Figure 38.

In Figure 38, the DMAC transfers data blocks in the order of Block A, Block B, and Block C. In the linked array chaining

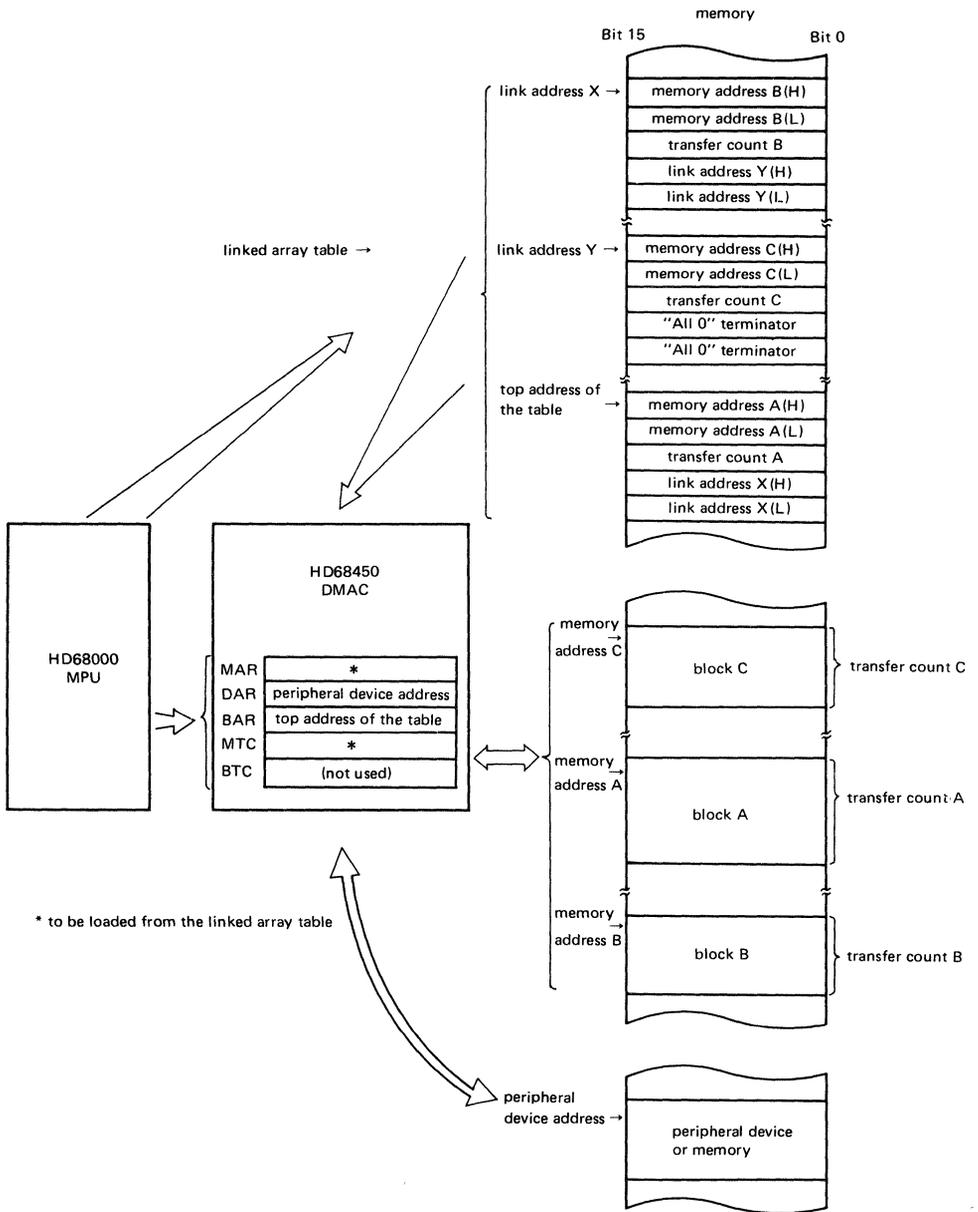


Figure 38 Transfer Example of the Linked Array Chaining Mode

mode, the BTC is not used. When the DMAC refers to the linked array table, the value of the BFC is outputted as the function code. The values of the function code registers are unchanged by the linked array chaining operation.

This type of chaining allows entries to be easily removed or inserted without having to reorganize data within the chain. Since the end of the chain is indicated by a terminal link, the number of entries in the array need not be specified to the DMAC.

The linked array table must start at an even address in the linked array chaining mode. Starting the table at an odd address results in an address error. If "0" is initially loaded to the MTC, the count error is signaled. Because the MPU can read all of the DMAC registers, all necessary error recovery information is available to the operating system.

The comparison of both chaining modes is shown in Table 8.

Table 8 Chaining Mode Address/Count Information

Chaining Mode	Base Address Register	Base Transfer Counter	Completed When
Array Chaining	address of the array table	number of data blocks being transferred	Base Transfer Count = 0
Linked Array Chaining	address of the linked array table	(unused)	Linked Address = 0

(4) Bus Exception Conditions

The DMAC has three lines for inputting bus exception conditions called \overline{BEC}_0 , \overline{BEC}_1 , and \overline{BEC}_2 . The priority encoder can be used to generate these signals externally. These lines are encoded as shown in Table 9.

Table 9

\overline{BEC}_2	\overline{BEC}_1	\overline{BEC}_0	Exception Condition
1	1	1	No exception condition
1	1	0	Halt
1	0	1	Bus error
1	0	0	Retry
0	1	1	Relinquish bus and retry
0	1	0	(undefined, reserved)
0	0	1	(undefined, reserved)
0	0	0	Reset

In order to guarantee reliable decoding, the DMAC verifies that the incoming code has been stable for two DMAC clock cycles before acting on it. The DMAC picks up \overline{BEC}_0 - \overline{BEC}_2 at the rising edge of the clock. If \overline{BEC}_0 - \overline{BEC}_2 is asserted to the undefined code, the operation of the DMAC does not proceed. For example, when the DMAC is waiting for \overline{DTACK} , inputting \overline{DTACK} does not result in the termination of the cycle if \overline{BEC}_0 - \overline{BEC}_2 is asserted to the undefined code. In addition, when the transfer request is received, \overline{BR} is not asserted if the \overline{BEC}_0 - \overline{BEC}_2 is not set to no exception condition.

If exception condition, except for HALT, is inputted during the DMA bus cycle prior to, or in coincidence with \overline{DTACK} , the DMAC terminates the current channel operation immediately. Here coincident means meeting the same set up requirements for the same sampling edge of the clock. If a bus exception condition exists, the DMAC does not generate any bus cycles until it is removed. However, the DMAC still recognizes requests.

Halt

The timing diagram of halt is shown in Figure 39. This diagram shows halt being generated during a read cycle from the 68000 compatible device in the dual addressing mode. If the halt exception is asserted during a DMA bus cycle, the DMAC does not terminate the bus cycle immediately. The DMAC waits for the assertion of \overline{DTACK} before terminating the bus cycle so that the bus cycle is completed normally. In the halted state, the DMAC puts all the control signals to high impedance and relinquishes the bus to the MPU. The DMAC does not output the \overline{BR} until halt exception is negated. When halt exception is negated, the DMAC acquires the bus again and proceeds the DMA operation. In order to insure a halt exception operation, the \overline{BEC} lines must be set to halt at least until the assertion of \overline{DTC} .

If the DMAC has the bus, but is not executing any bus cycle, the DMAC relinquishes the bus as soon as halt exception is asserted.

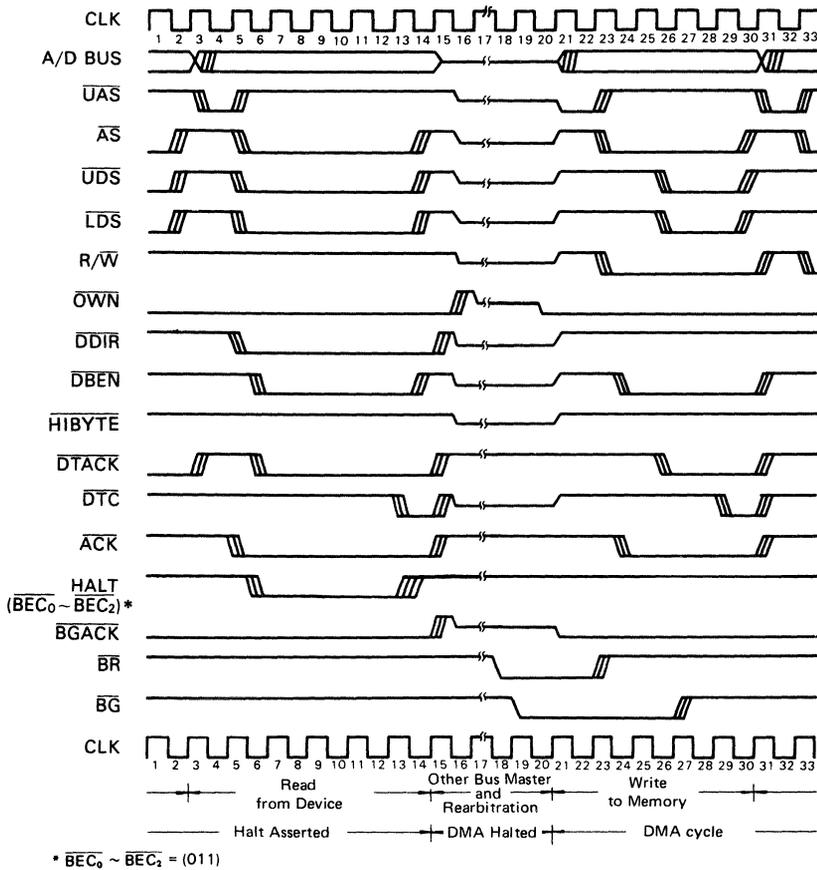


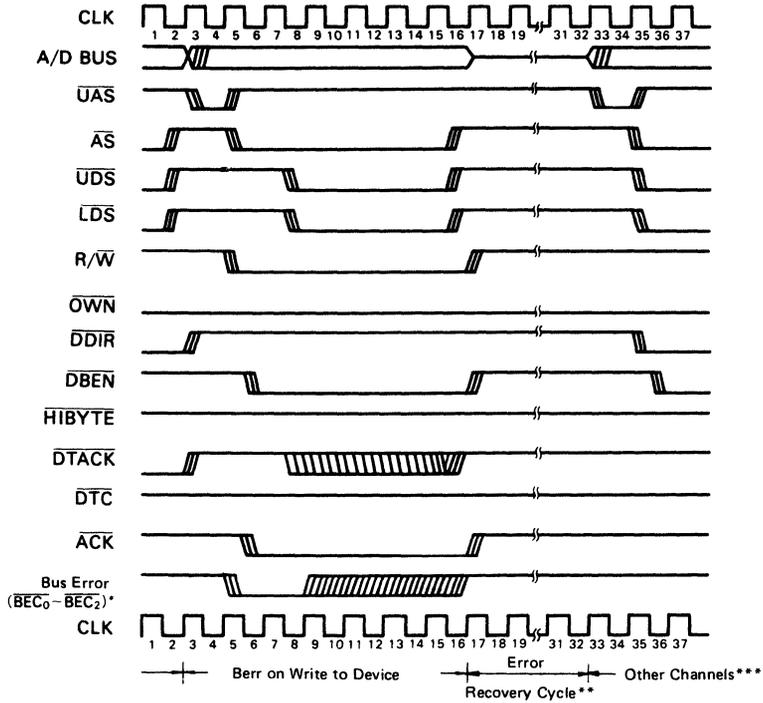
Figure 39 Halt Operation

Bus Error

The bus error exception is generated by external circuitry to indicate the current transfer cannot be successfully completed and is to be aborted. The recognition of this exception during a DMAC bus cycle signals the internal bus error condition for the channel for which the current bus cycle is being run. As soon as the DMAC recognizes the bus error exception, the DMAC immediately terminates the bus cycle and proceeds to the error recovery cycle. In this cycle, the DMAC adjusts the

values of the MAR, the DAR, the MTC and the BTC to the values when the bus error exception occurred. 25 clocks are required for the error recovery cycle in the single addressing mode and in the read cycle of the dual addressing mode. 29 clocks are required in the write cycle of the dual addressing mode. If the DMAC does not have any transfer request in the other channels after the error recovery cycle, the DMAC relinquishes the bus.

The diagram of the bus error timing is shown in Figure 40.



- * BEC₀-BEC₂ = (101)
- ** In the single addressing mode and in the read cycle of the dual addressing mode: 25 clocks
In the write cycle of the dual addressing mode: 29 clocks
- *** The DMAC keeps the bus because the other channels have requests pending. If other channels do not have requests, the DMAC relinquishes the bus after the error recovery cycle.

Figure 40 Bus Error Operation

Retry

The retry exception causes the DMAC to terminate the present operation and retry that operation when retry is re-

moved, and thus will not honor any requests until it is removed. However, the DMAC still recognizes requests. The retry timing is shown in Figure 41.

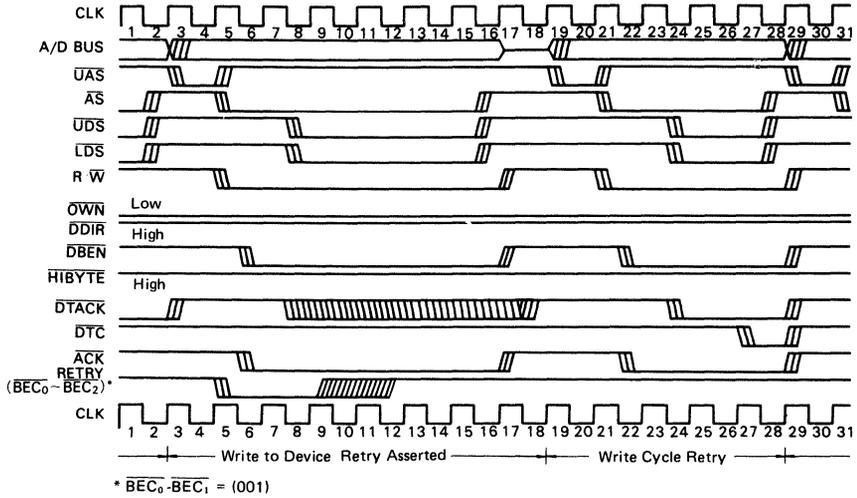


Figure 41 Retry Operation

Relinquish and Retry (R&R)

The relinquish and retry exception causes the DMAC to relinquish the bus and three-state all bus master controls and when the exception is removed, re-arbitrate for the bus to retry

the previous operation.

The diagram of the relinquish and retry timing is shown in Figure 42.

- tion is signaled during a DMA bus cycle.
- (e) Count Error – A count error occurs in the following cases:
 - (i) The STR bit is set when zero is set in the MTC and the MTC and the chaining mode is not used.
 - (ii) the STR bit is set when zero is set in BTC for the array chaining mode.
 - (iii) zero is loaded from memory to the BTC or the MTC in the chaining modes or the continue mode.
 - (f) External Abort – External abort occurs if an abort is asserted by the external circuitry when the PCL line is configured as an abort input and the STR or the ACT bit is set.
 - (g) Software abort – Software abort occurs if the SAB bit is set when the STR or the ACT bit is set.

Error Recovery Procedures

If an error occurs during a DMA transfer, appropriate information is available to the operating system (OS) to allow a software failure recovery operation. The operating system must be able to determine how much data was transferred, where the data was transferred to, an what type of error occurred.

The information available to the operating system consists of the present value of the Memory Address, Device Address and Base Address Registers, the Memory Transfer and Base Transfer Counters, the channel status register, the channel error register,

and the channel control register. After the successful completion of any transfer, the memory and device address registers point to the location of the next operand to be transferred and the memory transfer counter contains the number of operands yet to be transferred. If an error occurs during a transfer, that transfer has not completed and the registers contain the values they had before the transfer was attempted. If the channel operation uses chaining, the Base Address Register points to the next chain entry to be serviced, unless the termination occurred while attempting to fetch an entry in the chain. In that case, the Base Address Register points to the entry being fetched. However, in the case of external abort, there are cases in which the previous values are not recovered.

Bus Exception Operating Flow

The bus exception operating flow in the case of multiple exception conditions occurring continuously in sequence is shown in Figure 43. Note that the DMAC can receive and execute the next exception condition. For example, if the retry exception occurs, and next the relinquish and retry exception occurs while the DMAC is waiting for the retry condition to be cleared, the DMAC relinquishes the bus and waits for the exception condition to be cleared. If a bus error occurs during this period, the DMAC executes the bus error exception operation.

The flow diagram of the normal operation without exception operation or errors is shown in Figure 44.

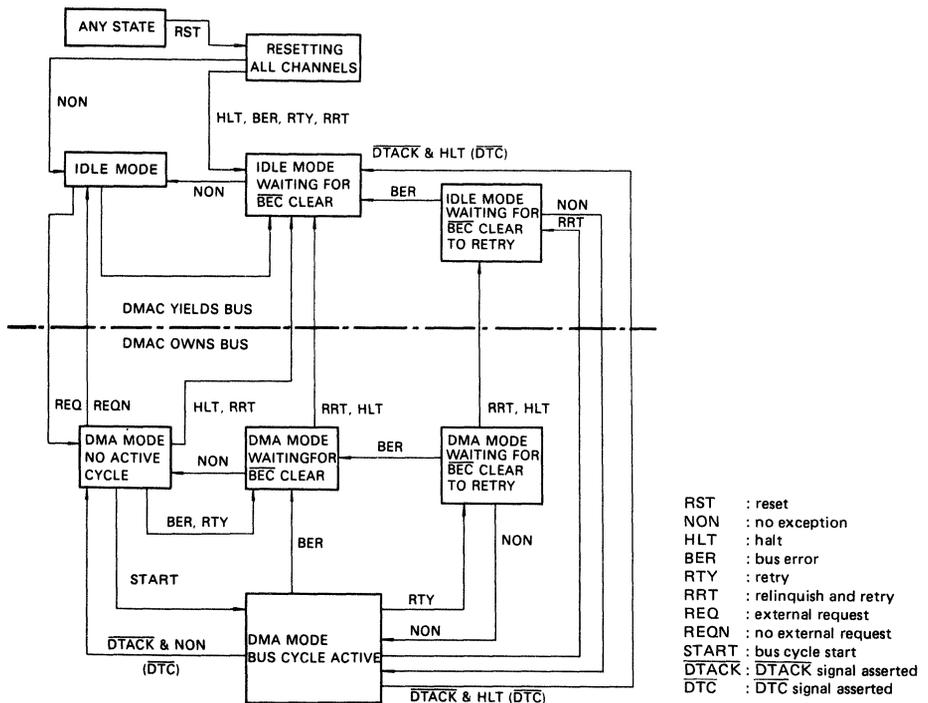


Figure 43 Bus Exception Flow Diagram

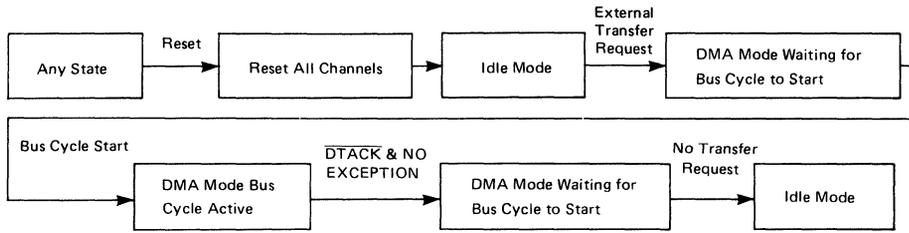


Figure 44 Flow of Normal Operation Without Exception or Error Condition

● Channel Priorities

Each channel has a priority level, which is determined by the contents of the Channel Priority Register (CPR). The priority of a channel is a number from 0 to 3, with 0 being the highest priority level. When multiple requests are pending at the DMAC, the channel with the highest priority receives first service. The priority of a channel is independent of the device protocol or the request mechanism for that channel. If there are several requesting channels at the highest priority level, a round-robin resolution is used, that is, as long as these channels continue to have requests, the DMAC does operand transfers in rotation.

Resetting the DMAC puts the priority level of all channels to "0", the highest priority level.

■ APPLICATIONS INFORMATION

Examples of how to interface HD68450 to a HD68000 based system are shown in Figure 45 and Figure 46.

Figure 45 shows an example of how to demultiplex the address/data bus. OWN and UAS are used to control 74LS373 for latching the address. DBEN and DDIR are used to control the bi-directional buffer 74LS245.

Figure 46 shows an example of inter-device connection in the HMCS68000 system.

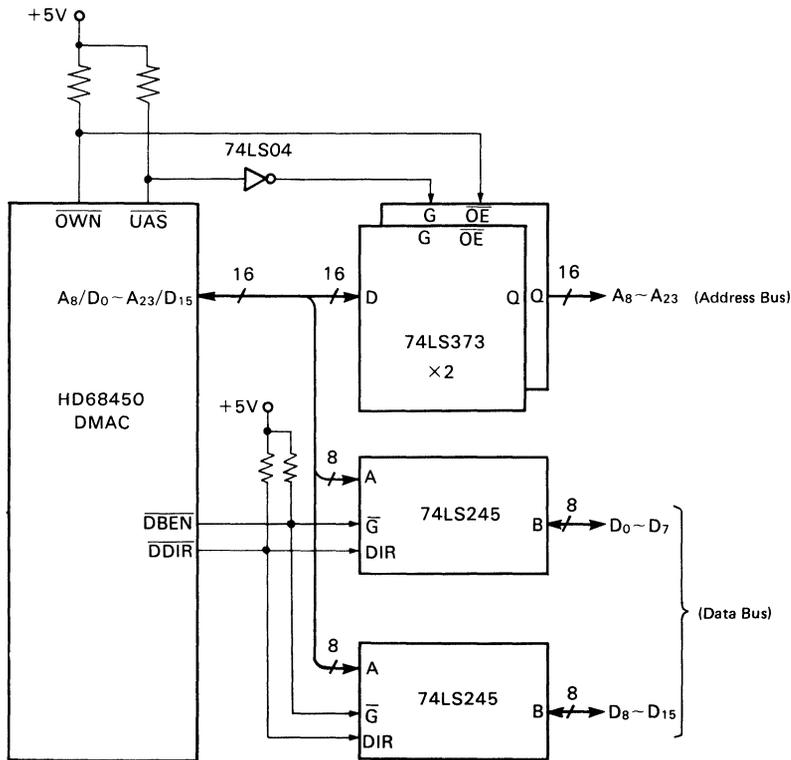
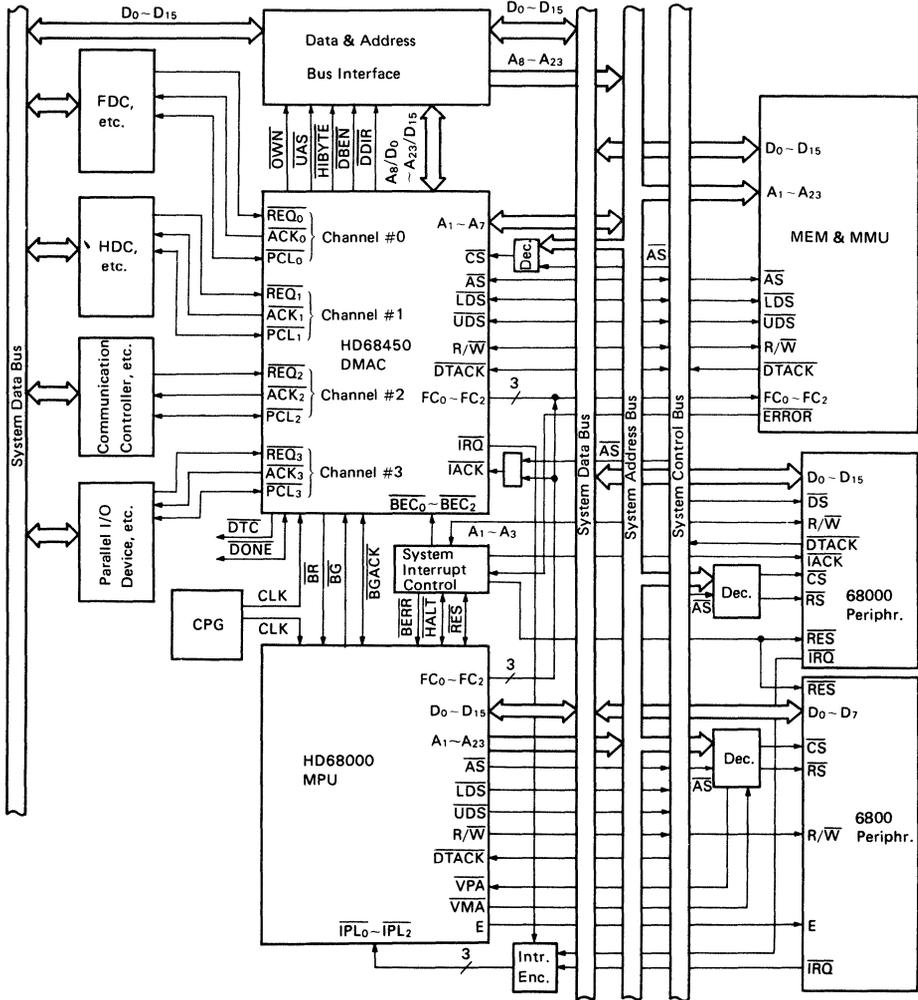


Figure 45 An Example of the Demultiplexed Address Data Bus



The address bus and the system control bus in each device are omitted in this Figure.

Figure 46 An Example of Inter-device Connection in the HMCS68000 System

■ ATTENTION ON USAGE

(1) How to interface various 6800 type peripheral devices to the DMAC based system.

When the DMAC is reading data from the 6800 device, the

DMAC latches the data when \overline{DTC} is asserted and not at the falling edge of E clock. The 74LS373 need to be provided externally as shown in Figure 47 so that the data from the 6800 device can be held on the bus for a large period of time until the DMAC can latch the correct data.

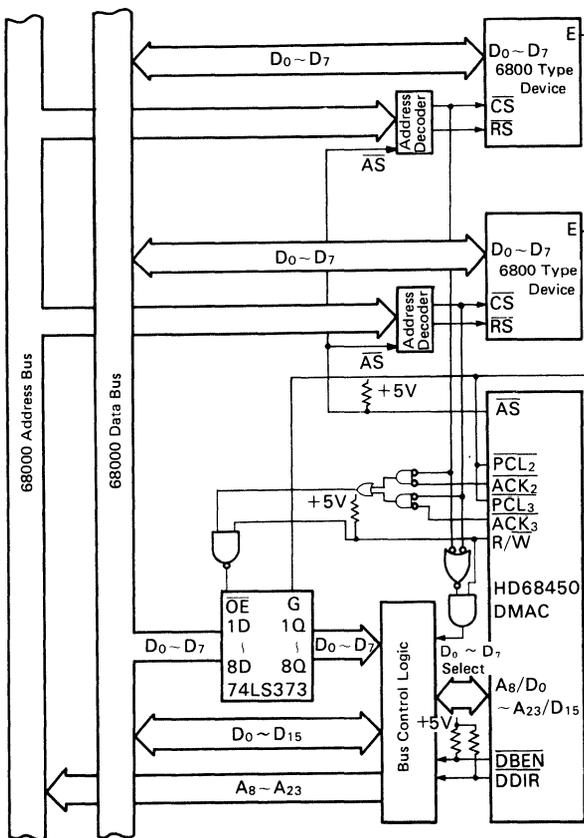


Figure 47 An Example of Connection with 6800 type Peripheral Devices (channel 2 and 3 are used)

(2) When "external abort" is inputted during the \overline{DONE} input cycle

When the transfer direction is from the peripheral device to memory and \overline{PCL} signal is set to the external abort input mode in the dual addressing mode, the external abort will be ignored during the subsequent write cycle from the DMAC's internal holding register to memory if \overline{DONE} is inputted during the read cycle from the peripheral device to the DMAC's internal holding register.

In this case, the channel status register (CSR) and the channel error register (CER) show the normal termination caused by \overline{DONE} Input. The user is able to examine the PCT bit and the ERR bit in order to detect the external abort

inputted at the timing described above. If PCT = 1, ERR = 0, and NDT = 1, then an external abort has occurred.

(3) Multiple Errors

The DMAC will log the first error encountered in the channel error register. If an error is pending in the error register and another error is encountered the second error will not be logged. Even though the second error is not logged in the CER, it will still be recognized internally and the channel will not start.

(4) The use of thick wiring is recommended between V_{SS} of the HD68450 and the ground of the circuit board. When a socket is used to install the DMAC on the board, please make sure that the contact of the V_{SS} pins are made well.

PRECAUTIONS:

1. Extra Data Transfer in the Burst Mode

In certain conditions when two or more channels are active and the REQ signal for the channel which is transferring in burst mode has negated, the transfer operation will terminate one data transfer later than specified in the data sheet. The condition on which this occurs is shown in Figure 2. Problems may occur in applications that need to control exact data transfer count using the REQ line in the burst mode.

(Countermeasure)

When switching the channel of operation using the burst request signals, negate the REQ signal within the period bounded by (3) and (4) in Figure 48. (DTC falling edge may be used for obtaining the timing for the negation of REQ.)

Caution must be taken when this countermeasure is used since this external circuit will not be compatible with the next mask version which will have this anomaly fixed.

NOTE 1: If transfer request is asserted in channel 1, before (1) which is 1 clock before DTC assertion of channel 0, the next bus cycle should be the bus cycle for channel 1 according to the data sheet. However, the current DMAC transfers one more data for channel 0 from 13th clock as shown above, before it changes to channel 1.

NOTE 2: If channel 1 has higher priority than channel 0, then NO extra data is transferred even if request for channel 1 is asserted before (2). In this case, data transfer for channel 1 starts from the 13th clock as specified in the data sheet.

*The timing in which one extra data is transferred in the burst mode (the case for changing from channel 0 to channel 1).

2. One byte of transfer data is left in the DMAC

When the DMAC is set to dual addressing mode, port size 8 bits, external request mode, and data transfer from peripheral device to memory, the last byte of the transfer may be left inside the DMAC's internal register without being transferred to memory if the transfer is stopped before the transfer count is exhausted. The last byte that is left inside the DMAC becomes inaccessible by the MPU.

In this mode, the DMAC transfers data repeating the following bus cycles:

- (1) READ BYTE
(Byte is read from the peripheral device to DMAC)
- (2) READ BYTE
(Byte is read from the peripheral device to DMAC)
- (3) WRITE WORD
(Word is written to memory from DMAC)

If the transfer is terminated after (1) READ BYTE (see NOTE*), then the byte data that was ready by (1) READ BYTE bus cycle is not written to memory and is left inside the DMAC's internal holding register. The DMAC's internal holding register cannot be accessed by the MPU, so that it becomes "lost."

This will not occur when single addressing mode is used. So, please use the single addressing mode when the transfer needs to be terminated before the transfer is exhausted.

Note:*The methods to terminate the transfer operation before the transfer counter becomes zero are (1) assert external abort using the PCL, (2) set the SAB bit to cause software abort.

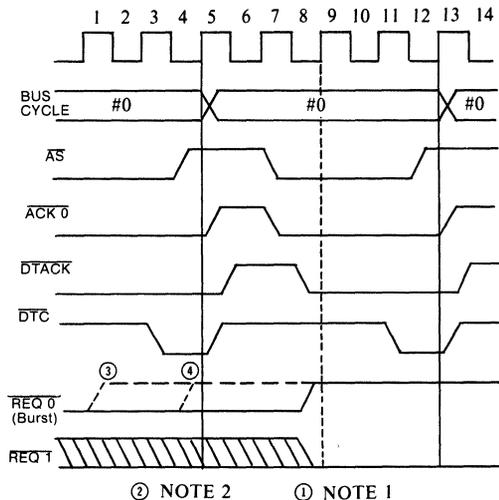


Figure 48. Extra Data Transfer in the Burst Mode*

HD63463-4, HD63463-6, HD63463-8 HDC (Hard Disk Controller)

The Hard Disk Controller (HDC) is a CMOS VLSI micro-computer peripheral device capable of controlling Winchester type hard disk drives. The HDC is also a new generation hard disk controller that controls several types of disk drive classified as follows.

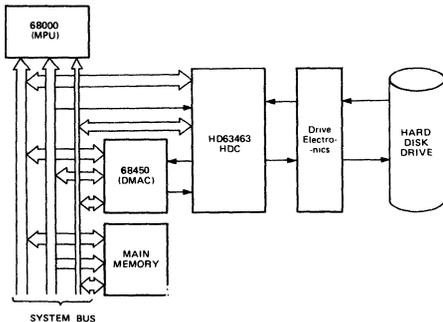
- (a) Interface type ; Floppy-like interface (Seagate interface)
SMD interface (Storage Module Device interface)
- (b) Media Format ; Hard sectored
Soft sectored

The control functions are greatly enhanced by the presence of powerful high level command and internal two Data Buffers. Therefore, the HDC can be applied to many applications with less CPU software overhead and it enhances system throughput.

■ FEATURES

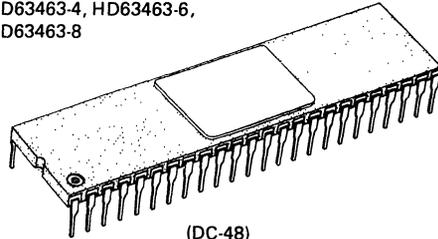
- Internal data buffer ; 512 bytes (256 bytes x 2)
- High level commands; RECALIBRATE, SEEK, READ DATA, READ ID, READ ERRONEOUS DATA, CHECK DATA, WRITE DATA, WRITE FORMAT SCAN, MEM to BUFFER, BUFFER TO MEM etc.
- Interfaceable drives
 - HDD interface : Floppy-like, SMD
 - Sector : Soft-sector, hard-sector
 - Serial data code : MFM, NRZ
- Track format
 - Tracks per side : Max. 8192 tracks
 - Sectors per track : Max. 255 sectors
 - Bytes per sector : 256, 512, 1024, 2048, 4096 bytes
- Error check & correction
 - 16 bit CRC
 - 32 bit fire code : Automatic error correction
- Multiple sector/Multiple track data transfer capability
- Parallel seek/Normal seek operation
- Control up to ; 4 drives with 8 heads (Floppy-like)
8 drives with 32 heads (SMD)
- DMA interface
- Diagnostic capability: Set high impedance state
- CMOS +5 V single power supply

■ SYSTEM CONFIGURATION



—ADVANCE INFORMATION—

HD63463-4, HD63463-6,
HD63463-8



■ PIN ARRANGEMENT

		Floppy-like	SMD	
VCC	1	48	RDY	BUSL/H
RES	2	47	SEEK	BUSR/W
DREQ	3	46	HSL ₂	TAG ₅
IRQ	4	45	HSL ₁	UTAG
DONE	5	44	HSL ₀	TAG ₃
RS ₁	6	43	US ₁	TAG ₂
DTACK	7	42	US ₀	TAG ₁
R/W	8	41	USLD	USLD
CS	9	40	SCP	SEC
DACK	10	39	IDX/TRZ	IDX
D ₀	11	38	LCT/DIR	BUS 4/9
D ₁	12	37	WFL	BUS 3/8
D ₂	13	36	PL/STP	BUS 2/7
CLK	14	35	PE/RGT	BUS 1/6
VSS	15	34	WGT	BUS 0/5
D ₃	16	33	VSS	
D ₄	17	32	SYNC	SKED
D ₅	18	31	RCLK	RCLK
D ₆	19	30	WCLK	WCLK
D ₇	20	29	RWDY	RWDY
D ₈ /RS ₀	21	28	D ₁₅	
D ₉	22	27	D ₁₄	
D ₁₀	23	26	D ₁₃	
D ₁₁	24	25	D ₁₂	

(Top View)

■ TYPE OF PRODUCTS

HDC	Clock Frequency (CLK)
HD63463-4	4 MHz
HD63463-6	6 MHz
HD63463-8	8 MHz

HD63484-4, HD63484-6, HD63484-8 ACRTC (Advanced CRT Controller)

—ADVANCE INFORMATION—

The Advanced CRT Controller (ACRTC) is a CMOS VLSI microcomputer peripheral device capable of controlling raster scan type CRTs to display both graphics and characters. The ACRTC is also a new generation CRT controller that is based on a bit-mapped technology and has more display control functions than those of an HD6845S (CRTC).

The ACRTC prepares the mechanisms to use at one of three modes; character only, graphic only and multiplexed character/graphic modes. Therefore, the ACRTC can be applied to many applications, from character only display devices to large full-graphic systems, as the key devices.

The ACRTC can reduce a CPU software overhead and enhance system throughput.

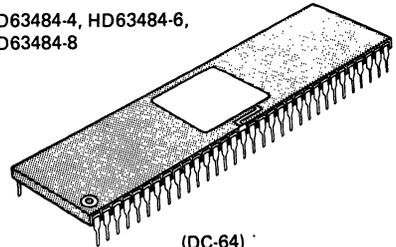
■ FEATURES

- High speed graphic drawings
 - Drawing rate : Maximum 500 ns/pixel (Color drawing)
 - Drawn graphics : Dot, Line, Rectangle, Poly-line, Polygon, Circle, Ellipse, Paint, Copy, etc.
 - Drawn colors : 16-bit/word
1-, 2-, 4-, 8-, 16-bit/pixel (5 types) monochrome to max. 64k colors.
- Large frame memory space
 - Maximum 2M bytes graphic memory
128k bytes character memory separated from the MPU memory
 - Available to maximum 4096 x 4096 high-resolution CRT (1 bit/pixel mode)
- Various CRT display controls
 - Split screens (3 displays and 1 window)
 - Zooming up (1 to 16 times)
 - Scroll (Vertical and horizontal)
- External synchronization
 - Synchronization between ACRTCs or between the ACRTC and external device (ex. TV system or other controller)
- DMA interface
- Two programmable cursors
- Three scan modes
 - Non-interlace, Interlace Sync. and Interlace Sync. & Video modes
- Interrupt request to MPU
- 256 characters/line, 32 rasters/line, 4096 rasters/screen
- Maximum clock frequency 8 MHz
- CMOS, +5V single power supply

■ TYPE OF PRODUCTS

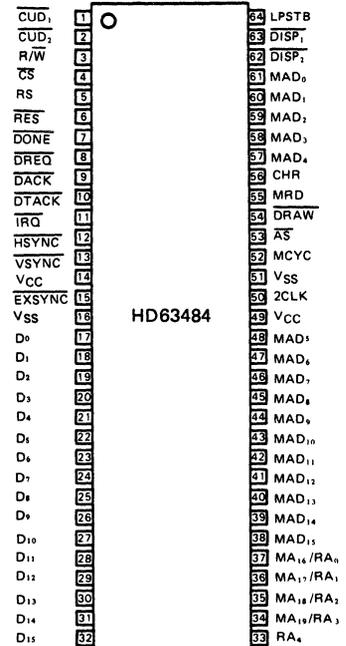
ACRTC	Clock Frequency (2CLK)
HD63484-4	4 MHz
HD63484-6	6 MHz
HD63484-8	8 MHz

HD63484-4, HD63484-6,
HD63484-8



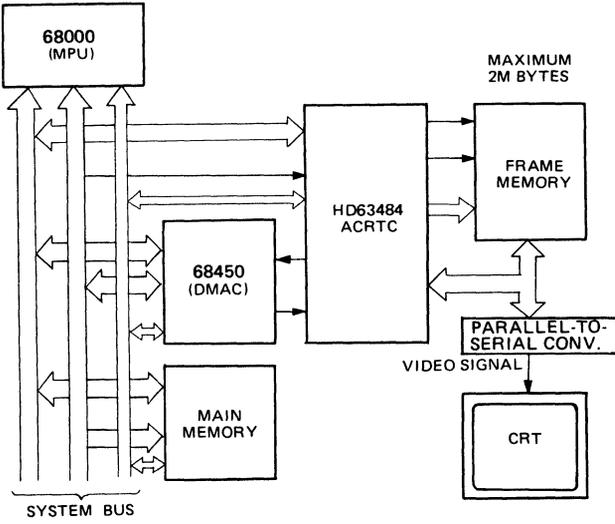
(DC-64)

■ PIN ARRANGEMENT



(Top View)

■ SYSTEM CONFIGURATION



INTRODUCTION OF RELATED DEVICES

- **8-bit Single-chip Microcomputers**
- **4-bit Single-chip Microcomputer
HMCS40 Series**
- **4-bit Single-chip Microcomputer
HMCS400 Series**
- **IC Memories**
- **Gate Array**
- **LCD Driver Series**
- **LSI for Speech Synthesizer System**
- **CODEC/Filter Combo LSI**



8-BIT SINGLE-CHIP MICROCOMPUTERS

■ NMOS 8-BIT SINGLE-CHIP MICROCOMPUTER HD6801 SERIES

Type No.		HD6801S0 HD6801S5	HD6801V0 HD6801V5	HD6803 HD6803-1	
LSI Characteristics	Bus Timing (MHz)	1.0/1.25	1.0/1.25	1.0/1.25	
	Supply Voltage (V)	5.0	5.0	5.0	
	Operating Temperature * (°C)	0 ~ +70	0 ~ +70	0 ~ +70	
	Package †	DP-40	DP-40	DP-40	
Functions	Memory	ROM (k byte)	2	4	—
		RAM (byte)	128	128	128
	I/O Port		29	29	13
	Interrupt	External	2	2	2
		Soft	1	1	1
		Timer	3	3	3
		Serial	1	1	1
	Timer		<ul style="list-style-type: none"> • Free running counter 16-bit x 1 • Output compare register 16-bit x 1 • Input capture register 16-bit x 1 		
	SCI	Full double step-stop type			
	External Memory Expansion	<ul style="list-style-type: none"> • Address/data non-multiple mode (256 bytes) • Address/data multiple mode (65k bytes) 		<ul style="list-style-type: none"> • Address/data multiple mode (65k bytes) 	
	Clock Pulse Generator	Built-in (External clock useable)			
Built-in RAM Holding	Yes (64 bytes)				
EPROM on the Package Type**		HD68P01V07 HD68P01V07-1	HD68P01V07 HD68P01V07-1	—	
Compatibility		MC6801 MC6801-1	—	MC6803 MC6803-1	

* Wide Temperature Range (-40 ~ +85°C) version is available.

** HD68P01M0 and HD68P01M0-1 are useable.

† DP; Plastic DIP

8-BIT SINGLE-CHIP MICROCOMPUTERS

■ NMOS 8-BIT SINGLE-CHIP MICROCOMPUTER HD6805 SERIES

Type No.		HD6805S1	HD6805S6*	HD6805U1			
LSI Characteristics	Clock Frequency (MHz)	1.0	1.0	1.0			
	Supply Voltage (V)	5.25	5.25	5.25			
	Operating Temperature *** (°C)	0 ~ +70	0 ~ +70	0 ~ +70			
	Package †	DP-28	DP-28	DP-40			
Functions	Memory	ROM (k byte)	1.1	1.8	2		
		RAM (byte)	64	64	96		
	I/O Port	I/O Port	20	20	20	32	24
		Input Port		—			8
		Output Port		—			—
	Interrupt	Nesting	6	6	6		
		External	1	1	1		
		Soft	1	1	1		
		Timer	1	1	1		
		Serial	—	—	—		
	Timer	<ul style="list-style-type: none"> • 8-bit timer with 7-bit prescaler • Event counter 					
	SCI	—	—	—			
	Clock Pulse Generator	<ul style="list-style-type: none"> • Resistor • Crystal 					
	Low-voltage Automatic Reset (LVI)	Yes	Yes	Yes			
	Self-check Mode	Available	Available	Available			
	External Memory Expansion	—	—	—			
Other Features							
EPROM on the Package Type		—	—	HD68P05V07			
Compatibility		MC6805P2	MC6805P6	—			

* Preliminary ** Under development

*** Wide Temperature Range (-40 ~ +85°C) version is available.

† DP; Plastic DIP

8-BIT SINGLE-CHIP MICROCOMPUTERS

HD6805V1		HD6805T2**		HD6805W1*	
1.0		1.0		1.0	
5.25		5.25		5.25	
0 ~ +70		0 ~ +70		0 ~ +70	
DP-40		DP-28		DP-40	
4		2.5		4	
96		64		96	
32	24	19	19	29	23
	8		—		6
	—		—		—
6		6		12	
1		1		2	
1		1		1	
1		1		4	
—		—		—	
				<ul style="list-style-type: none"> • 8-bit timer with 7-bit prescaler • Event counter • 8-bit comparator 	
—		—		—	
		<ul style="list-style-type: none"> • Crystal 			
Yes		Yes		Yes	
Available		Available		Available	
—		—		—	
		PLL logic for RF synthesizer		<ul style="list-style-type: none"> • 8-bit x 4-channel internal A/D converter • 8 bytes of standby RAM 	
HD68P05V07		—		HD68P05W0*	
—		MC6805T2		—	

8-BIT SINGLE-CHIP MICROCOMPUTERS

■ CMOS 8-BIT SINGLE-CHIP MICROCOMPUTER HD6301 SERIES

Type No.		HD6301V1 HD63A01V1 HD63B01V1	HD6301X0* HD63A01X0* HD63B01X0*	
LSI Characteristics	Bus Timing (MHz)	1.0 (HD6301V1) 1.5 (HD63A01V1) 2.0 (HD63B01V1)	1.0 (HD6301X0) 1.5 (HD63A01X0) 2.0 (HD63B01X0)	
	Supply Voltage (V)	5.0	5.0	
	Operating Temperature*** (°C)	0 ~ +70	0 ~ +70	
	Package †	DP-40, FP-54, CG-40	DP-64S, FP-80	
Functions	Memory	ROM (k byte)	4	
		RAM (byte)	128	
	I/O Port	I/O Port	29	29
		Input Port	—	53
		Output Port	—	24
	Interrupt	External	2	3
		Soft	2	2
		Timer	3	4
		Serial	1	1
	Timer	16-bit x 1 (Free running counter x 1 Output compare register x 1 Input capture register x 1)	16-bit x 1 (Free running counter x 1 Output compare register x2 Input capture register x1 8-bit x 1 (8-bit up counter x 1 Time constant register x 1)	
	SCI	Asynchronous	Asynchronous/Synchronous	
	External Memory Expansion	65k bytes	65k bytes	
Other Features	<ul style="list-style-type: none"> •Error detection •Low power consumption modes (sleep and standby) 	<ul style="list-style-type: none"> •Error detection •Low power consumption modes (sleep and standby) •Slow memory interface •Halt 		
EPROM on the Package Type		HD63P01M1 HD63PA01M1* HD63PB01M1*	HD63701X0** (EPROM on-chip)	

* Preliminary ** Under development *** Wide Temperature Range (-40 ~ +85°C) version is available.

† DP; Plastic DIP, FP; Plastic Flat Package, CG; Glass-sealed Ceramic Leadless Chip Carrier

8-BIT SINGLE-CHIP MICROCOMPUTERS

HD6301Y0** HD63A01Y0** HD63B01Y0**	HD6303R HD63A03R HD63B03R	HD6303X* HD63A03X* HD63B03X*	HD6303Y** HD63A03Y** HD63B03Y**
1.0 (HD6301Y0) 1.5 (HD63A01Y0) 2.0 (HD63B01Y0)	1.0 (HD6303R) 1.5 (HD63A03R) 2.0 (HD63B03R)	1.0 (HD6303X) 1.5 (HD63A03X) 2.0 (HD63B03X)	1.0 (HD6303Y) 1.5 (HD63A03Y) 2.0 (HD63B03Y)
5.0	5.0	5.0	5.0
0 ~ +70	0 ~ +70	0 ~ +70	0 ~ +70
DP-64S, FP-64	DP-40, FP-54, CG-40	DP-64S, FP-80	DP-64S, FP-64
16	-	-	-
256	128	192	256
53	13	24	24
48	13	16	24
-	-	8	-
5	-	-	-
3	2	3	3
2	2	2	2
4	3	4	4
1	1	1	1
16-bit x 1 (Free running counter x 1) (Output compare register x 2) (Input capture register x 1) 8-bit x 1 (8-bit up counter x 1) (Time constant register x 1)	16-bit x 1 (Free running counter x 1) (Output compare register x 1) (Input capture register x 1)	16-bit x 1 (Free running counter x 1) (Output compare register x 2) (Input capture register x 1) 8-bit x 1 (8-bit up counter x 1) (Time constant register x 1)	16-bit x 1 (Free running counter x 1) (Output compare register x 2) (Input capture register x 1) 8-bit x 1 (8-bit up counter x 1) (Time constant register x 1)
Asynchronous/Synchronous	Asynchronous	Asynchronous/Synchronous	Asynchronous/Synchronous
65k bytes	65k bytes	65k bytes	65k bytes
<ul style="list-style-type: none"> •Error detection •Low power consumption modes (sleep and standby) •Slow memory interface •Halt 	<ul style="list-style-type: none"> •Error detection •Low power consumption modes (sleep and standby) 	<ul style="list-style-type: none"> •Error detection •Low power consumption modes (sleep and standby) •Slow memory interface •Halt 	<ul style="list-style-type: none"> •Error detection •Low power consumption modes (sleep and standby) •Slow memory interface •Halt

8-BIT SINGLE-CHIP MICROCOMPUTERS

■ CMOS 8-BIT SINGLE-CHIP MICROCOMPUTER HD6305 SERIES

Type No.		HD6305U0** HD63A05U0** HD63B05U0**	HD6305V0** HD63A05V0** HD63B05V0**	HD6305X0* HD63A05X0* HD63B05X0*			
LSI Characteristics	Clock Frequency (MHz)	1.0 (HD6305U0) 1.5 (HD63A05U0) 2.0 (HD63B05U0)	1.0 (HD6305V0) 1.5 (HD63A05V0) 2.0 (HD63B05V0)	1.0 (HD6305X0) 1.5 (HD63A05X0) 2.0 (HD63B05X0)			
	Supply Voltage (V)	5.0	5.0	5.0			
	Operating Temperature *** (°C)	0 ~ +70	0 ~ +70	0 ~ +70			
	Package †	DP-40	DP-40	DP-64S, FP-64			
Functions	Memory	ROM (k byte)	2	4	4		
		RAM (byte)	128	192	128		
	I/O Port	I/O Port	31	31	31	55	32
		Input Port		—			7
		Output Port		—			16
	Interrupt	External	2	2	2		
		Soft	1	1	1		
		Timer	2	2	2		
		Serial	1	1	1		
	Timer						
	SCI						
	External Memory Expansion	—	—	—			
	Other Features						
EPROM on the Package Type		—	—	HD63P05Y0** HD63PA05Y0** HD63PB05Y0**			
Evaluation Chip		—	—	—			

* Preliminary ** Under development *** Wide Temperature Range (-40 ~ +85°C) version is available.

† DP; Plastic DIP, FP; Plastic Flat Package

8-BIT SINGLE-CHIP MICROCOMPUTERS

HD6305X1* HD63A05X1* HD63B05X1*		HD6305X2* HD63A05X2* HD63B05X2*		HD6305Y0* HD63A05Y0* HD63B05Y0*		HD6305Y1* HD63A05Y1* HD63B05Y1*		HD6305Y2* HD63A05Y2* HD63B05Y2*		HD63L05F1
1.0 (HD6305X1) 1.5 (HD63A05X1) 2.0 (HD63B05X1)		1.0 (HD6305X2) 1.5 (HD63A05X2) 2.0 (HD63B05X2)		1.0 (HD6305Y0) 1.5 (HD63A05Y0) 2.0 (HD63B05Y0)		1.0 (HD6305Y1) 1.5 (HD63A05Y1) 2.0 (HD63B05Y1)		1.0 (HD6305Y2) 1.5 (HD63A05Y2) 2.0 (HD63B05Y2)		0.1
5.0		5.0		5.0		5.0		5.0		3.0
0 ~ +70		0 ~ +70		0 ~ +70		0 ~ +70		0 ~ +70		-20 ~ +75
DP-64S, FP-64		DP-64S, FP-64		DP-64S, FP-64		DP-64S, FP-64		DP-64S, FP-64		DP-64S, FP-80
4		-		8		8		-		4
128		128		256		256		256		96
31	24	31	24	55	32	31	24	31	24	20
	7		7		7		7		-	
	-		-		16		-		-	
2		2		2		2		2		1
1		1		1		1		1		1
2		2		2		2		2		1
1		1		1		1		1		-
<ul style="list-style-type: none"> • 8-bit x 1 (with 7-bit prescaler) • 15-bit x 1 (combined with SCI) 										<ul style="list-style-type: none"> • 8-bit x 1 (with 7-bit prescaler)
Synchronous										-
12k bytes		16k bytes		-		8 k bytes		16k bytes		-
<ul style="list-style-type: none"> • Low power consumption modes (Wait, stop and standby) 										<ul style="list-style-type: none"> • 8-bit A/D converter • LCD driver (6 x 7 segment) • Low power consumption modes (Standby and halt)
-	-	-	-	-	-	-	-	-	-	-
-	-	-	-	-	-	-	-	-	-	HD63L05E0

8-BIT SINGLE-CHIP MICROCOMPUTERS

■ NMOS 8-BIT SINGLE-CHIP MICROCOMPUTER EPROM ON- PACKAGE TYPE

Type No.		HD68P01V07	HD68P01V07-1*	HD68P01M0	HD68P01M0-1*	HD68P05V07	HD68P05W0*
LSI Characteristics	Supply Voltage (V)	5.0				5.0	5.0
	Operating Temperature** (°C)	0 ~ +70				0 ~ +70	0 ~ +70
	Package †	DC-40P				DC-40P	DC-40P
Equivalent Device		HD6801V0	HD6801V5	—	—	HD6805U1 HD6805V1	HD6805W1
Mountable EPROM		HN482732A-30	HN482732A-30	HN482764-3	HN482764-3	HN482732A-30	HN482732A-30 HN482764-3

* Preliminary

** Wide Temperature Range (-40 ~ +85°C) version is available.

† DC; Ceramic DIP (EPROM on the package type)

■ CMOS 8-BIT SINGLE-CHIP MICROCOMPUTER EPROM ON-PACKAGE TYPE

Type No.		HD63P01M1	HD63PA01M1*	HD63PB01M1*	HD63P05Y0**	HD63PA05Y0**	HD63PB05Y0**	
LSI Characteristics	Supply Voltage (V)	5.0				5.0		
	Operating Temperature*** (°C)	0 ~ +70				0 ~ +70		
	Package †	DC-40P				DP-64SP		
Equivalent Device		HD6301V1	HD63A01V1	HD63B01V1	HD6305X0 HD6305Y0	HD63A05X0 HD63A05Y0	HD63B05X0 HD63B05Y0	
Mountable EPROM		HN482732A-30 HN482764-3 HN27C64-30	HN482732A-30 HN482764-3 HN27C64-30	HN482732A-25 HN482764 HN27C64-25	HN482732A-30 HN482764-3 HN27C64-30	HN482732A-30 HN482764-3 HN27C64-30	HN482732A-25 HN482764 HN27C64-25	

* Preliminary

** Under Development

*** Wide Temperature Range (-40 ~ +85°C) version is available.

† DC; Ceramic DIP (EPROM on the package type)

8-BIT SINGLE-CHIP MICROCOMPUTERS

■ CMOS 8-BIT SINGLE-CHIP MICROCOMPUTER EPROM ON-CHIP TYPE

Type No.		HD63701X0*		
LSI Characteristics	Bus Timing (MHz)		1.0	
	Supply Voltage (V)		5.0	
	Operating Temperature (°C)		0 ~ +70	
	Package †		DC-64S	
Functions	Memory	ROM (k byte)	4 (EPROM)	
		RAM (byte)	192	
	I/O Port	I/O Port	53	24
		Input Port		8
		Output Port		21
	Interrupt	External	3	
		Soft	2	
		Timer	4	
		Serial	1	
	Timer	16-bit x 1 (Free running counter x 1 Output compare register x 2 Input capture register x 1 8-bit x 1 (8-bit up counter x 1 Time constant register x 1)		
	SCI	Asynchronous/Synchronous		
	External Memory Expansion	65k bytes		
Other Features	<ul style="list-style-type: none"> • Error detection • Low power consumption modes (sleep and standby) • Slow memory interface • Halt 			
Equivalent Device		HD6301X0		

* Under development

† DC; Ceramic DIP (Shrink type)

4-BIT SINGLE-CHIP MICROCOMPUTER HMCS40 SERIES

The HMCS40 Series are high performance, low cost 4-Bit Single-Chip Microcomputers designed for dedicated applications. The HMCS40 Series Instruction Set provides convenient chip

selection and system expansion.

LCD-III/IV are LCD driver on chip microcomputers designed for applications which need an LCD display device.

FEATURES

- Full Line-Up: CMOS
 - 2 ~ 4k Words ROM
 - 160 ~ 256 Words RAM
 - 32 ~ 44 I/O Lines
- All Instructions (except Pattern Generation Instruction) are Single cycle.
- Pattern Generation Instruction (Table Reference Capability).
- Powerful Interrupt Function.

- 3 Interrupt Sources
 - 2 External Interrupt Line
 - 1 Timer/Counter
- Low Power Dissipation (2mW): CMOS.
- Low Operating Voltage Version (3V): CMOS.
- Built-in Clock Pulse Generator (Resistor or Ceramic Filter).
- Built-in Power-on Reset Circuitry.
- I/O Options (User Selectable at Each Pin).
 - CMOS: Pull up Resistor/Open Drain/CMOS Output
- Built-in LCD drive circuit: LCD-III/IV.

■ HMCS40 SERIES PRODUCT CHARACTERISTICS

Family Name (Type Name)		HMCS44CL (HD44808) HMCS44C (HD44800)	HMCS45CL (HD44828) HMCS45C (HD44820)	HMCS46CL (HD44848) HMCS46C (HD44840)	HMCS47CL (HD44868) HMCS47C (HD44860)	LCD-III *3 (HD44795, HD44790)	LCD-IV (HD613)	
LSI Characteristics	Process Technology	CMOS	CMOS	CMOS	CMOS	CMOS	CMOS	
	Supply Voltage (V _{CC}) (V)	3/5	3/5	3/5	3/5	3/5	3/5	
	Power Dissipation (Typ.) (mW)	0.32/2	0.32/2	0.32/4	0.32/4	0.36/2.4	0.9/5.0	
	Max. I/O Terminal Voltage (V)	V _{CC} + 0.3	V _{CC} + 0.3	V _{CC} + 0.3				
	Operating Temperature Range *1 (°C)	-20 ~ +75	-20 ~ +75	-20 ~ +75	-20 ~ +75	-20 ~ +75	-20 ~ +75	
	Package	DP-42, DP-42S	FP-54, DP-64S	DP-42, DP-42S	FP-54, DP-64S	FP-80	FP-80	
	Memory	ROM (bits)	2,048 × 10 128 × 10 ⁺²	2,048 × 10 128 × 10 ⁺²	4,096 × 10	4,096 × 10	2,048 × 10 128 × 10 ⁺²	4,096 × 10
		RAM (bits)	160 × 4	160 × 4	256 × 4	256 × 4	160 × 4	256 × 4
	Registers	8	6	8	6	6	6	
	Stack Registers	4	4	4	4	4	4	
Functions	I/O Ports	4-Bit Data Input	32	44	32	44	32	44
		Discrete Input	—	—	—	—	—	—
		4-Bit Data Output	—	4 × 1	—	4 × 1	—	4 × 1
		Discrete Output	—	—	—	—	—	—
		4-Bit Data Input/Output	4 × 4	4 × 6	4 × 4	4 × 6	4 × 2	4 × 4
		Discrete Input/Output	1 × 16	1 × 16	1 × 16	1 × 16	1 × 16	1 × 16
Interrupts	External	2	2	2	2	2	2	
	Timer/Counter	1	1	1	1	1	1	
Instructions	Number of Instructions	71	71	71	71	71	71	
	Cycle Time (μs)	20/10	20/10	20/5	20/5	20/10	20/5	
Built-in Clock Pulse Generator								
Power on Reset	No/Yes	No/Yes	No/Yes	No/Yes	No/Yes	Yes	No	
Battery Back-up	Halt	Halt	Halt	Halt	Halt	Halt	Halt	
Evaluation Chip		HD44850E HD44857E	HD44850E HD44857E	HD44857E	HD44857E	HD44797E	HD44797E	

*1 Wide Temperature Range (-40 ~ +85°C) version is available.

*2 Pattern Memory

*3 LCD DRIVE FUNCTION

LCD Drive	Common	4
	Segment	32
	Duty	Static, 1/2, 1/3, 1/4
	Bias	1/2, 1/3
Display Capability		4x32 Matrix (1/4 Duty)

Expandable using the LCD Driver HD44100H

4-BIT SINGLE-CHIP MICROCOMPUTER HMCS400 SERIES

The new CMOS 4-bit HMCS400 microcomputer series comes satisfying the growing needs for microcomputer systems with large program capacity and high function for advanced applications. The HMCS400 series strengthens the proven capabilities of the HMCS40 series, offering high software productive architecture, enhanced peripheral functions and high speed instruction execution.

■ FEATURES

- Architectural Compatible with the HMCS40 Series for Easy Replacement
- One Cycle per Instruction Execution Utilizing 10-bit per Instruction
- Powerful ROM and RAM Addressing Capability

- 16 Subroutine Stack Levels
- 98 Instructions Including Logic Arithmetic Operating Instruction, BCD Arithmetic Operating Instruction and Pattern Generating Instruction
- Five Interrupt Levels (External: 2, Timer/Counter: 2, Serial Interface: 1)
- 8-bit Serial Interface (Clock Synchronous Type)
- Two Timer/Counters: 8-bit Free Running Timer and 8-bit Reload Timer/Event Counter
- 58 I/O Lines (26 High Voltage 40V I/O Lines)
- High Speed Instruction Execution: 2 μ s at V_{CC} 5V, High Speed Version (1.3 μ s) Available
- EPROM on the Package Type Available for System Emulation

■ HMCS400 SERIES PRODUCT CHARACTERISTICS

Family Name		HMCS404CL*	HMCS404C*	HMCS404AC*	
LSI Characteristics	Process Technology	CMOS	CMOS	CMOS	
	Supply Voltage (V)	2.5 ~ 6.0	4 ~ 6	4.5 ~ 5.5	
	Power Dissipation (max.) (mW)	9	18	27	
	Max. I/O Terminal Voltage (V)	$V_{CC} - 40$	$V_{CC} - 40$	$V_{CC} - 40$	
	Operating Temperature Range ($^{\circ}$ C)	-20 ~ +75	-20 ~ +75	-20 ~ +75	
	Package	FP-64, DP-64S	FP-64, DP-64S	FP-64, DP-64S	
Functions	Memory	ROM (bits)	4096 x 10	4096 x 10	4096 x 10
		RAM (bits)	256 x 4	256 x 4	256 x 4
	Registers	7	7	7	
	Subroutine Stack Levels	16	16	16	
	I/O Ports	4-Bit Input	4 x 1	4 x 1	4 x 1
			2 x 1	2 x 1	2 x 1
		4-Bit Output	4 x 4	4 x 4	4 x 4
			4 x 5	4 x 5	4 x 5
	1-Bit Input/Output	1 x 16	1 x 16	1 x 16	
		Interrupts	External	2	2
	Timer/Counter		2	2	2
	Serial Interface		1	1	1
	Instruction	Number of Instructions	99	99	99
		Cycle Time (μ s)	4	2	1.33
Clock Pulse Generator	Built-in (External drive is possible)				
Others	Power Saving Mode (Stop mode, Stand-by mode)				
EPROM on the Package Type		HD614P080S*			

*Preliminary

IC MEMORIES

■ MOS RAM

Mode	Total Bit	Type No.	Process	Organiza- tion (word x bit)	Access Time (ns) max	Cycle Time (ns) min	Supply Voltage (V)	Power Dissipation (W)	Package †							
									Pin No.	CG	G	P	FP	SP		
Static	16k-bit	HM6116-2	CMOS	2048 x 8	120	120	+5	0.1m/0.2	24	●	●	●	●			
		HM6116-3			150	150		0.1m/0.18		●	●	●	●			
		HM6116-4			200	200		0.1m/0.18		●	●	●	●			
		HM6116L-2			120	120		20μΔ/0.18			●	●	●			
		HM6116L-3			150	150		20μΔ/0.16			●	●	●			
		HM6116L-4			200	200					●	●	●			
		HM6116A-12			120	120						●		●		
		HM6116A-15			150	150		0.1m/15m					●	●		
		HM6116A-20			200	200							●	●		
		HM6116AL-12			120	120							●	●		
		HM6116AL-15			150	150		5μ/10m						●		
		HM6116AL-20			200	200								●		
		HM6117-3			150	150								●		
		HM6117-4			200	200		0.1m/0.2						●		
		HM6117L-3			150	150								●		
		HM6117L-4		200	200	10μ/0.18						●				
		HM6168H-45		45	45	4096 x 4		45	45	0.1m/0.25	20	●	●			
		HM6168H-55		55	55			55	55	0.1m/0.25		●	●			
		HM6168H-70		70	70			70	70	5μ/0.25		●	●			
		HM6168HL-45		45	45			45	45	5μ/0.25		●	●			
		HM6168HL-55		55	55			55	55			●	●			
		HM6168HL-70		70	70			70	70			●	●			
		HM6167		70	70	16384 x 1		70	70	0.1m/0.15	20	●	●			
		HM6167-6		85	85			85	85	0.1m/0.15		●	●			
		HM6167-8		100	100			100	100	5μ/0.15		●	●			
		HM6167L		70	70			70	70	0.1m/0.2		●	●			
		HM6167L-6		85	85			85	85	5μ/0.2		●	●			
		HM6167L-8		100	100			100	100	0.1m/0.2		●	●			
		HM6167H-45		45	45			45	45	5μ/0.2		●	●			
		HM6167H-55		55	55			55	55	0.1m/0.25		●	●			
		HM6167HL-45		45	45			45	45			●	●			
		HM6167HL-55		55	55			55	55			●	●			
		HM6267-35		35	35			35	35			●	●			
	HM6267-45	45	45	45	45			●	●							
	HM6264-10	100	100	8192 x 8	100		100	0.1m/0.2	28	●		●				
	HM6264-12	120	120		120		120	0.1m/0.2		●		●				
	HM6264-15	150	150		150		150	10μ/0.2		●		●				
	HM6264L-10	100	100		100	100		●		●						
	HM6264L-12	120	120		120	120		●		●						
	HM6264L-15	150	150		150	150		●		●						

(Continued)

IC MEMORIES

Mode	Total Bit	Type No.	Process	Organiza-tion (word x bit)	Access Time (ns) max	Cycle Time (ns) min	Supply Voltage (V)	Power Dissipation (W)	Package †										
									Pin No.	CG	G	P	FP	SP					
Dynamic	64k-bit	HM48416A-12	NMOS	16384 x 4	120	230	+5	20m/0.3	18				●						
		HM48416A-15			150	260							●						
		HM48416A-20			200	330							●						
		HM4864-2			150	270				65536 x 1	20m/0.33	16			●	●			
		HM4864-3			200	335										●	●		
		HM4864A-12			120	220										●	●	●	
	HM4864A-15	150		260					●				●	●					
	HM4864A-20	200		330					●				●	●					
	HM50256-12	120		220	262144 x 1	20m/0.25		16						●	●				
	HM50256-15	150		260								●	●						
	HM50256-20	200		330								●	●						
	HM50257-12	120		220					20m/0.35	16				●	●				
	HM50257-15	150		260										●	●				
	HM50257-20	200		330										●	●				
	HM50257-20	200		330							●	●							

Δ HM6116LP/LFP Series : 10 μW

† The package codes of CG, G, P, FP and SP are applied to the package materials as follows.

CG: Glass-sealed Ceramic Leadless Chip Carrier, G: Cerdip, P: Plastic DIP, FP: Plastic Flat Package (SOP), SP: Skinny Type Plastic DIP

■ MOS ROM

Mode	Total Bit	Type No.	Process	Organization (word x bit)	Access Time (ns) max	Supply Voltage (V)	Power Dissipation (W)	Package †										
								Pin No.	C	G	P	FP						
Mask	64k-bit	HN61364	CMOS	8192 x 8	250	+5	5μ/50m	28				●	●					
		HN61365			250							●						
		HN61366			250							●						
	128k-bit	HN613128			250				28				●	●				
		HN61256			32768x8 or 65536 x 4					3500				●	●			
	256k-bit	HN613256			32768 x 8				250				5μ/50m					
HN613256		131072 x 8	350				2m/75m											
U.V. Erasable & Electrically	32k-bit	HN482732A-20	NMOS	4096 x 8	200	+5	0.18/0.8	24		●								
		HN482732A-25			250							●						
		HN482732A-30			300							●						
	64k-bit	HN482764			8192 x 8				250	0.18/0.55	28			●				
		HN482764-2							200						●			
		HN482764-3							300						●			
		HN27C64-15							150			0.55m/0.17	28				●	
		HN27C64-20							200								●	
		HN27C64-25							250								●	
	HN27C64-30	300									●							
	128k-bit	HN4827128-25			16384 x 8				250	0.18/0.53	28				●			
		HN4827128-30							300						●			
		HN4827128-45							450						●			
	256k-bit	HN27256-20			32768 x 8				200	0.22/0.55	28				●			
		HN27256-25							250						●			
		HN27256-30							300						●			
	On Time Electrically	64k-bit			HN482764-3				NMOS	8192 x 8	300	+5	0.18/0.55	28			●	
		128k-bit			HN4827128-30*					16348 x 8	300		0.18/0.53				●	
Electrically Erasable & Programmable	64k-bit	HN58064-25	NMOS	8192 x 8	250	+5	0.22/0.55	28				●						
		HN58064-30			300							●						
		HN58064-45			450							●						

* Preliminary

† The package codes of C, G, P and FP are applied to the package material as follows.

C: Side-brazed Ceramic DIP, G: Cerdip, P: Plastic DIP, FP: Plastic Flat Package

■ BIPOLAR RAM

Level	Total Bit	Type No.	Organization (word x bit)	Output	Access Time (ns) max	Supply Voltage (V)	Power Dissipation (mW/bit)	Package †					
								Pin No.	F	G	P	CC	
ECL 10k	256	HM10414	256 x 1	Open Emitter	10	-5.2	2.8	16		●			
		HM10414-1			8					●			
	1k	HM2110	1024 x 1		35				●				
		HM2110-1			25				●				
		HM2112			10				●				
		HM2112-1			8				●				
	HM10422	256 x 4	10				0.8		●	●			
			7				1.0	24	●	●			
			25				0.2	18		●			
	15		0.3				●						
	25		0.2		20				●				
	4k	HM10474	1024 x 4		10			0.3	24		●		
					8			0.3			●		
					10			0.05	20		●	●	
					25			0.06			●		
					16k		HM10480-15*	16384 x 1	15		0.06	28	
20						0.06				●			
HM10480-20*	4096 x 4	15							●				
		20							●				

* Under development

† The package codes of F, G, P and CC are applied to the package materials as follows.
 F: Flat Package, G: Cerdip, P: Plastic DIP, CC: Ceramic Leadless Chip Carrier.

GATE ARRAY

CMOS Gate Array HD61J/HD61K/HD61L/HD61MM Series

■ FEATURES

- Fast operation
 - Internal gate (2-input NAND, FO=3, AL=3mm) . . . 3.5ns typ
 - Input buffer (FO=3, AL = 3mm) 9ns typ
 - Output buffer (C_L=50pF) 20ns typ
 - Memory access time (HD61MM) 60ns typ
- Low power dissipation
 - At 10MHz operation (Internal gate) 130μW/gate typ
- Abundant input and output configuration
 - Allocation of all pins except power supply pins to input/output/input-output
 - Output can be CMOS/open drain/3-state
- Memory on-chip (HD61MM)
 - Flexibility of memory capacity and word organization
 - Selection of single port/dual port memory
- Wide operation temperature range
 - 20 to +75°C
- Wide package selection
 - Especially plastic packages with high pin count DILP64/FPP100
- Powerful design support
 - User-Defined-Macro
 - Test pattern evaluation with fault simulator
 - Design support at local Design Center
- Quick turn around time and reasonable development cost

■ LINE UP

		HD61J	HD61K	HD61L	HD61MM*
Gate count		504	1080	1584	2496
I/O pin count		50	68	68	104
RAM on chip		—	—	—	available
Package	DP28	○	○	○	—
	DP42	○	○	○	—
	DP64	—	○	○	○
	FP54	○	—	—	—
	FP80	—	○	○	—
	FP100	—	—	—	○*
	DC28	○	○	○	○
	DC40	○	○	○	○
	PGA72	—	—	○	—
PGA120	—	—	—	○*	
Power supply pin		4			4 8*

* Preliminary

Bi-CMOS Gate Array HD27K/HD27L/HD27P/HD27Q Series

■ FEATURES

- High speed with super low power dissipation
 - Internal gate: 4.0ns (Fan out=3) @0.05mW
 - Input buffer: 5.0ns (Fan out=3) @2.6mW
 - Output buffer: 8.0ns (C_L=15pF) @2.6mW
- LS TTL compatible input/output
 - Selectable totem-pole/3-state/open collector output
 - I_{OL}=8mA: Capable of driving 20 LS TTL's
- Output buffer can construct logic functions.
 - Saves gate stages.
- A variety of macrocell library
 - Internal gate: 44
 - Output buffer: 9
- A variety of reliable package
 - Plastic DIP 16 to 64 pins
 - Plastic FP 60 to 100 pins (under development)
- A variety of DA system support
 - Only logic diagrams and test patterns needed as an interface with the user.
- Short development time

	Number of gates			Number of V _{CC} and GND pins	Package	
	Internal gate (2-input NAND)	Input buffer	Output buffer		DIP (Plastic)	FP* (Plastic)
HD27K	200	18	18	2	16, 20, 28, 42 pins	—
HD27L	528	30	30	4	28, 42, 64 pins	60, 80 pins
HD27P	966	40	40	4	28, 42, 64 pins	60, 80, 100 pins
HD27Q	1530	50	50	4	28, 42, 64 pins	60, 80, 100 pins

*Under development

LCD DRIVER SERIES

■ LCD DRIVER SERIES CHARACTERISTICS

Type		General		Segment Display			
LSI Characteristics	Type Number	HD44100H	HD61100	HD61602	HD61603	HD44780 (LCD-II)	
	Process	CMOS	CMOS	CMOS	CMOS	CMOS	
	Supply Voltage (V)	5*1	5*1	3 ~ 5*1	3 ~ 5*1	5*1	
	Operating Temperature (°C)	-20 ~ +75	-20 ~ +75	-20 ~ +75	-20 ~ +75	-20 ~ +75*2	
	Package	FP-60	FP-100	FP-80	FP-80	FP-80	
	Power Dissipation (mW)	5.0	5.0	0.5 (5V)	0.5 (5V)	1.75	
Functions	Memory	ROM (bits)	—	—	—	7200 (CG)*3	
		RAM (bits)	—	—	51 x 4	64 x 1	80 x 8/64 x 8 (CG)*3
	I/O	Interface (CPU)	8	8	14	10	11
		Interface (Driver IC)	2	2	—	—	4
		Interface (External ROM, RAM)	—	—	—	—	—
	Number of Instruction		—	—	4	4	11
	LCD Driver	Common	40	80	4	1	16
		Segment			51	64	40
Duty		Free (N)	Free (N)	Static, 1/2, 1/3, 1/4	Static	1/8, 1/11, 1/16	
Display Capability		N x 40 Matrix (1/N Duty)	N x 80 Matrix (1/N Duty)	204 Segment (1/4 Duty)	64 Segment	16 Digits (5 x 7 Dots 1/16 Duty)	
Comment		SR type	SR type			Expandable to 80 Digits using HD44100H	

*1: Except Power Supply for LCD.

*2: -40 ~ +85°C (Special Request). Please contact Hitachi Agents.

*3: CG; Character Generator.

Character Display		Graphic Display					
HD44101H	HD43160AH	HD44102CH	HD44103CH	HD44105H	HD61830	HD61102	HD61103
CMOS	CMOS	CMOS	CMOS	CMOS	CMOS	CMOS	CMOS
5*1	5*1	5*1	5*1	5*1	5*1	5*1	5*1
-20 ~ +75	-20 ~ +75	-20 ~ +75	-20 ~ +75	-20 ~ +75	-20 ~ +75	-20 ~ +75	-20 ~ +75
FP-80	FP-54	FP-80	FP-60	FP-60	FP-60	FP-100	FP-100
1.75	10.0	2.5	4.0	4.0	30.0	3.0	5.0
6720 (CG)*3	6240 (CG)*3	—	—	—	7360 (CG)*3	—	—
32 x 8	80 x 8	200 x 8	—	—	(external 65536 x 8)	512 x 8	—
12	21	21	6	6	13	21	6
4	5	—	5	5	9	—	5
—	18	—	—	—	33	—	—
8	6	6	—	—	12	7	—
15	—	—	20	32	—	—	64
40	—	50	—	—	—	64	—
1/7, 1/14	1/8, 1/12, 1/16	1/8, 1/12, 1/16, 1/24, 1/32	1/8, 1/12, 1/16, 1/24, 1/32	1/8, 1/12, 1/16, 1/24, 1/32, 1/48, 1/64	Static, 1/1 ~ 1/128	~ 1/64	1/48, 1/64 1/96, 1/128
16 Digits (5 x 7 Dots 1/14 Duty)	—	32 x 50 Dots (1/32 Duty)	—	—	—	64 x 64 Dots (1/64 duty)	—
Expandable to 32 Digits using HD44100H	Display to 80 Digits using HD44100H	Segment Driver	Common Driver	Common Driver	Display to 524288 Dots using HD44100H	Segment Driver	Common Driver

LSI FOR SPEECH SYNTHESIZER SYSTEM

PMOS 3-chip System

OUTLINE OF BASIC DEVICE

Type name	Function	Explanation of function	Outline
HD38880B	Speech synthesizer	Synthesizes speech by reading out a prescribed characteristic parameter from the ROM chip according to the command from the microcomputer.	DC-28 DP-28
HD38884P	128k-bit ROM	Analyzes the speech which should be synthesized in advance and stores the extracted characteristic parameter.	DP-28
HD38882P	EPROM interface	Capable of 1M-bit connection when using EPROM.	DP-42
HMCS40* Series	Controller	Performs overall control to synthesize special speech under suitable conditions.	*

*See 4-bit microcomputer item.

System Features

High speech quality

Since a PARCOR system is employed and the bit rate can be taken up to 2400~9600 bits/sec, excellent tone quality is made possible.

Synthesizing woman's voice

In addition to a man's voice, synthesizing woman's voice is possible with the adoption of the vocal tract loss effect.

Variation of speaking speed

Speech can be spoken slowly or rapidly by microcomputer control.

Vocalization with accurate scale

By producing voice pitch through external synchronization, accurately scaled singing is possible.

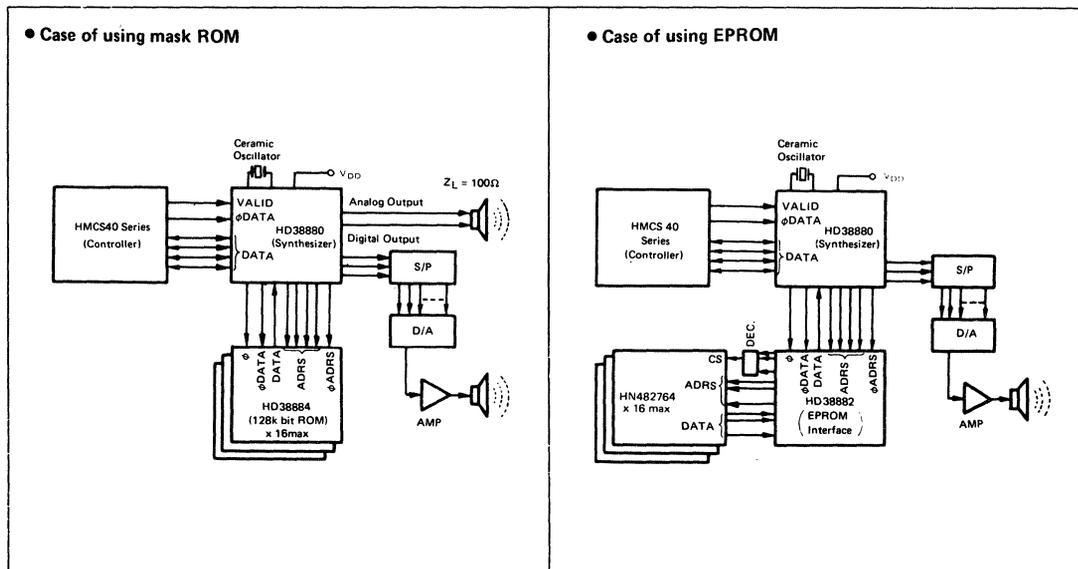
Long-period voice capacity

A maximum of 16 ROMs can be connected without an interface circuit. Vocal sound of 50~100 seconds (2400 bit/sec) can be synthesized with 1 ROM.

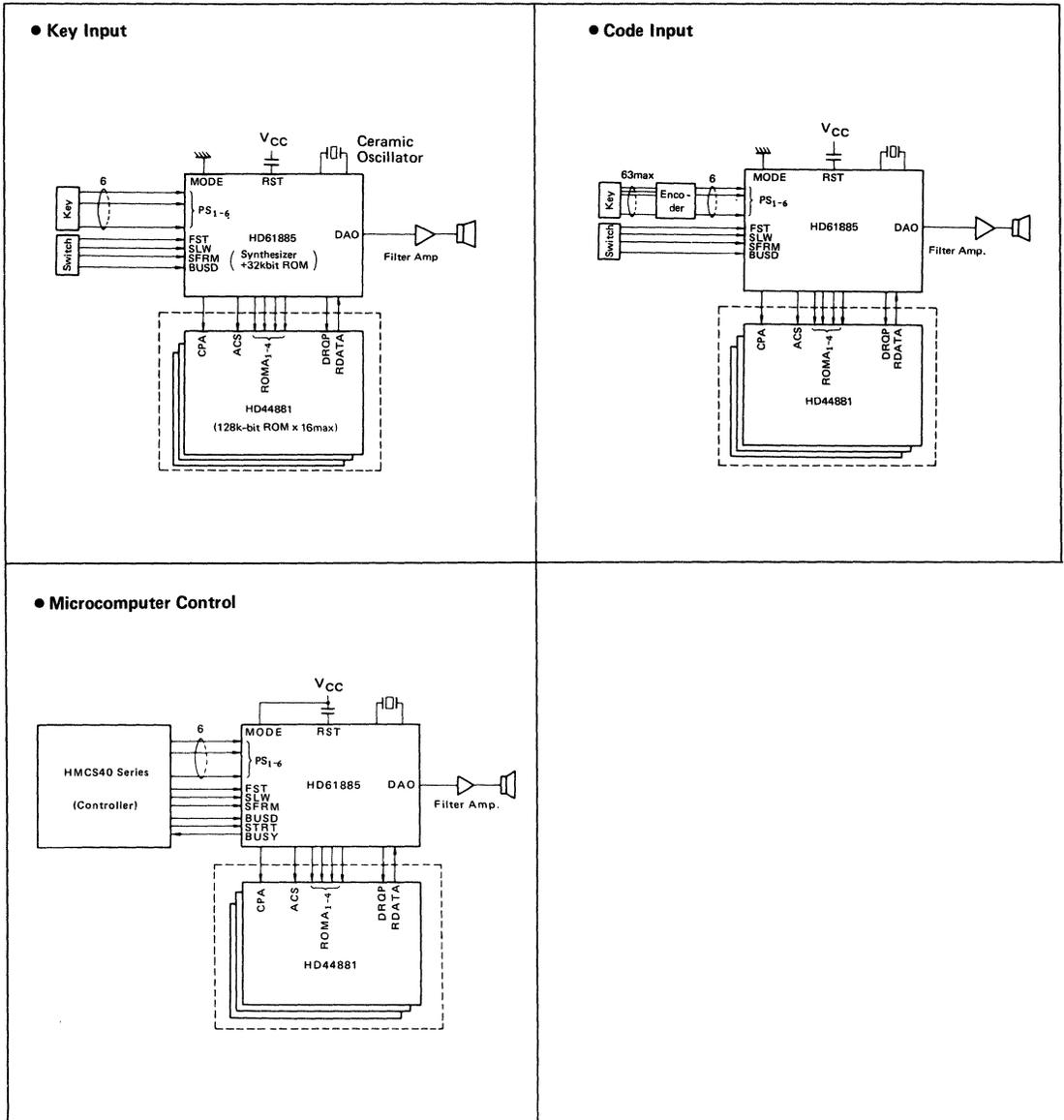
Speaker direct drive

The speaker is directly driven by the built-in D/A converter and speaker driving circuit. Excellent tone quality and power is possible by providing an external D/A converter and speaker driving circuit utilizing the digital output.

BASIC SYSTEM COMPOSITION EXAMPLES



■ BASIC SYSTEM COMPOSITION EXAMPLES



CODEC/FILTER COMBO LSI

■ LINE UP

Series	Type No.	Comp. Law	Power Dissipation (mW)	CR Filter	Voltage Reference	Clock			Signaling	Package
						Internal Clock	Sync./ Async.	PCM Bit Clock Required		
HD44210	HD44211A	A	150	—	—	External 128 kHz req.	Both	64 ~ 2048kHz	—	DC-24
	HD44212A	μ								
HD44220	HD44222	μ	40	—	External	PLL	Both	64 ~ 2048kHz	Decoder Shift	DC-16
HD44230	HD44231B	A	60	○	○	Divider	Sync.	1536/1544/2048kHz	—	DG-16
	HD44232B	μ								
	HD44233B	A								
	HD44234B	μ	50	○	○	PLL	Both	64 ~ 2048kHz	—	
	HD44235	A							Decoder Shift	
	HD44236	μ					—			
	HD44237	A					Decoder Shift			
HD44238	μ	60	○	○	Divider	Sync.	1536/1544/2048kHz	—		
HD44231C	A									
HD44232C	μ									
HD44233C	A				PLL	Both	64 ~ 2048kHz	—		
HD44234C	μ							Decoder Shift		
HD44235C	A							—		
HD44236C	μ							Decoder Shift		
HD44237C	A	PLL	Both	64 ~ 2048kHz	—					
HD44238C	μ				Decoder Shift					
HD44240C	HD44240C	μ	60	○	○	PLL	Both	64 ~ 2048kHz	A/B Data I/O	DG-20

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μ-law ; U.S.A., Canada & Japan

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